

RK3168

Technical Reference Manual

Revision 2.1
Dec. 2013

Revision History

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2012-07-19	1.0	Initial Release
2012-09-08	2.0	Update GRF, CRU and PMU section
2013-12-14	2.1	Update io list, Power supply sequence for USB

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Acronym Descriptions

Chapter 1 Introduction

RK3168 is a low power, high performance processor for mobile phones, personal mobile internet device and other digital multimedia applications, and integrates dual-core Cortex-A9 with separately NEON and FPU coprocessor.

Many embedded powerful hardware engines provide optimized performance for high-end application. RK3168 supports almost full-format video decoder by 1080p@60fps, also support H.264 encoder by 1080p@30fps, high-quality JPEG encoder/decoder, special image preprocessor and postprocessor .

Embedded 3D GPU makes RK3168 completely compatible with OpenGL ES2.0 and 1.1, OpenVG 1.1. Special 2D hardware engine with MMU will maximize display performance and provide very smoothly operation.

RK3168 has high-performance external memory interface(DDR3/LPDDR2/LVDDR3) capable of sustaining demanding memory bandwidths, also provides a complete set of peripheral interface to support very flexible applications as follows :

- 2 banks, 8bits/16bits Nor Flash/SRAM interface
- 4 banks, 8bits/16bits async Nand Flash,LBA Nand Flash and 8bits sync ONFI Nand Flash, allup to 60bits hardware ECC
- Totally 2GB memory space for 2 ranks, 16bits/32bits DDR3-800 , LPDDR2-800, LVDDR3-800
- Totally 3-channels SD/MMC interface to support MMC4.41, SD3.0, SDIO3.0 or eMMC
- 2-channels TFT LCD interface with 5-layers , 1920x1080 maximum display size
- Oe-channels, 8bits CCIR656 interface and 10bits/12bits raw data interface with image preprocessor
- Audio interface : one 2ch I2S/PCM interface and SPDIF tx interface
- 10M/100M RMII ethenet interface
- High-speed ADC interface and TS stream interface
- Lots of low-speed peripheral interface : 5I2C, 4UART, 2SPI,4PWM

This document will provide guideline on how to use RK3168 correctly and efficiently. The chapter 1 and chapter 2 will introduce the features, block diagram, signal descriptions and system usage of RK3168, the chapter 3 through chapter 45 will describe the full function of each module in detail.

1.1 Features

1.1.1 MicroProcessor

- Dual-core ARM Cortex-A9 MPCore processor , a high-performance, low-power and cached application processor
- Full implementation of the ARM architecture v7-A instruction set, ARM Neon Advanced SIMD (single instruction, multiple data) support for accelerated media and signal processing computation
- Superscalar, variable length, out-of-order pipeline with dynamic branch prediction, 8-stage pipeline
- Include VFPv3 hardware to support single and double-precision add, subtract, divide, multiply and accumulate, and square root operations
- SCU ensures memory coherency between the two CPUs
- Integrated timer and watchdog timer per CPU
- Integrated 32KB L1 instruction cache , 32KB L1 data cache with 4-way set associative
- 256KB unified L2 Cache

- Trustzone technology support
- Full coresight debug solution
 - Debug and trace visibility of whole systems
 - ETM trace support
 - Invasive and non-invasive debug
- One separate power domain for secondary core to support internal power switch and externally turn on/off based on different application scenario
 - PD_A9_1: 2nd Cortex-A9 + Neon + FPU + L1 I/D Cache
- One isolated voltage domain to support DVFS
- Maximum frequency can be up to 1GHz@0.9V(Worst Case)

1.1.2 Memory Organization

- Internal on-chip memory
 - 10KB BootRom
 - 16KB internal SRAM for security and non-security access, detailed size is programmable
 - 128KB or 256KB internal SRAM shared with L2 Cache Memory
- External off-chip memory^①
 - DDR3-800, 16/32bits data widths, 2 ranks, totally 2GB(max) address space, maximum address space for one rank is also 2GB.
 - LPDDR2-800, 32bits data width, 2 ranks, totally 2GB(max) address space, maximum address space for one rank is also 2GB.
 - Async SRAM/Nor Flash, 8/16bits data width, 2 banks
 - Async Nand Flash(include LBA Nand), 8/16bits data width, 4 banks, 60bits ECC
 - Sync ONFI Nand Flash, 8bits data width, 8 banks, 60bits ECC

1.1.3 Internal Memory

- Internal BootRom
 - Size : 10KB
 - Support system boot from the following device :
 - ◆ 8bits/16bits Async Nand Flash
 - ◆ 8bits ONFI Nand Flash
 - ◆ SPI0 interface
 - ◆ eMMC interface
 - Support system code download by the following interface:
 - ◆ USB OTG interface
 - ◆ UART0 Interface
- Internal SRAM
 - Size : 16KB
 - Support security and non-security access
 - Security or non-security space is software programmable
 - Security space can be 0KB, 4KB, 8KB, 12KB, 16KB continuous size
- 128KB or 256KB internal SRAM shared with L2 Cache for Cortex-A9, size is configurable by software.

1.1.4 External Memory or Storage device

- Dynamic Memory Interface (DDR3/LPDDR2)
 - Compatible with JEDEC standard DDR3/LPDDR2 SDRAM
 - Data rates up to 800Mbps(400MHz) for DDR3/LPDDR2
 - Support up to 2 ranks (chip selects), totally 2GB(max) address space, maximum address space for one rank is also 2GB, which is software-configurable.

- 16bits/32bits data width is software programmable
- 5 host ports with 64bits AXI bus interface for system access, AXI bus clock is asynchronous with DDR clock
- Programmable timing parameters to support DDR3/LPDDR2 SDRAM from various vendor
- Advanced command reordering and scheduling to maximize bus utilization
- Low power modes, such as power-down and self-refresh for DDR3/LPDDR2 SDRAM; clock stop and deep power-down for LPDDR2 SDRAM
- Compensation for board delays and variable latencies through programmable pipelines
- Embedded dynamic drift detection in the PHY to get dynamic drift compensation with the controller
- Programmable output and ODT impedance with dynamic PVT compensation
- Support one low-power work mode: power down DDR PHY and most of DDR IO except two cs and two cke output signals , make SDRAM still in self-refresh state to prevent data missing.
- Static Memory Interface (ASRAM/Nor Flash)
 - Compatible with standard async SRAM or Nor Flash
 - Support up to 2 banks (chip selects)
 - For bank0, 8bits/16bits data width is software programmable; For bank1, 16bits data width is fixed
 - Support separately data and address bus, also support shared data and address bus to save IO numbers
- Nand Flash Interface
 - Support 8bits/16bits async nand flash, up to 4 banks
 - Support 8bits sync DDR nand flash, up to 4 banks
 - Support LBA nand flash in async or sync mode
 - Up to 60bits hardware ECC
 - For DDR nand flash, support DLL bypass and 1/4 or 1/8 clock adjust, maximum clock rate is 75MHz
 - For async nand flash, support configurable interface timing , maximum data rate is 16bit/cycle
 - Embedded special DMA interface to do data transfer
 - Also support data transfer together with general DMAC1 in SoC system
- eMMC Interface
 - Compatible with standard iNAND interface
 - Support MMC4.41 protocol
 - Provide eMMC boot sequence to receive boot data from external eMMC device
 - Support combined single FIFO(32x32bits) for both transmit and receive operations
 - Support FIFO over-run and under-run prevention by stopping card clock automatically
 - Support CRC generation and error detection
 - Embedded clock frequency division control to provide programmable baud rate
 - Support block size from 1 to 65535Bytes
 - 8bits data bus width

- SD/MMC Interface
 - Compatible with SD3.0, MMC ver4.41
 - Support combined single FIFO(32x32bits) for both transmit and receive operations
 - Support FIFO over-run and under-run prevention by stopping card clock automatically
 - Support CRC generation and error detection
 - Embedded clock frequency division control to provide programmable baud rate
 - Support block size from 1 to 65535Bytes
 - Data bus width is 4bits

1.1.5 System Component

- CRU (clock & reset unit)
 - Support clock gating control for individual components inside RK3168
 - One oscillator with 24MHz clock input and 4 embedded PLLs
 - Up to 2.2GHz clock output for all PLLs
 - Support global soft-reset control for whole SOC, also individual soft-reset for every components
- PMU(power management unit)
 - 6 work modes(slow mode, normal mode, idle mode, stop mode, sleep mode, power-off mode) to save power by different frequency or automatical clock gating control or power domain on/off control
 - Lots of wakeup sources in different mode
 - 3 separate voltage domains
 - 6 separate power domains, which can be power up/down by software based on different application scenes
- Timer
 - 3 on-chip 32bits Timers in SoC with interrupt-based operation
 - Provide two operation modes: free-running and user-defined count
 - Support timer work state checkable
 - Fixed 24MHz clock input
- PWM
 - Four on-chip PWMs with interrupt-based operation
 - Programmable 4-bit pre-scalar from apb bus clock
 - Embedded 32-bit timer/counter facility
 - Support single-run or continuous-run PWM mode
 - Provides reference mode and output various duty-cycle waveform
- WatchDog
 - 32 bits watchdog counter width
 - Counter clock is from apb bus clock
 - Counter counts down from a preset value to 0 to indicate the occurrence of a timeout
 - WDT can perform two types of operations when timeout occurs:
 - ◆ Generate a system reset
 - ◆ First generate an interrupt and if this is not cleared by the service routine by the time a second timeout occurs then generate a system reset
 - Programmable reset pulse length

- Totally 16 defined-ranges of main timeout period
- Bus Architecture
 - 64-bit multi-layer AXI/AHB/APB composite bus architecture
 - 5 embedded AXI interconnect
 - ◆ CPU interconnect with three 64-bits AXI masters, two 64-bits AXI slaves, one 32-bits AHB master and lots of 32-bits AHB/APB slaves
 - ◆ PERI interconnect with two 64-bits AXI masters, one 64-bits AXI slave, one 32-bits AXI slave, four 32-bits AHB masters and lots of 32-bits AHB/APB slaves
 - ◆ Display interconnect with six 64-bits AXI masters and one 32-bits AHB slave
 - ◆ GPU interconnect with one 128-bits AXI master and 64-bits AXI slave ,they are point-to-point AXI-lite architecture
 - ◆ VCODEC interconnect also with one 64-bits AXI master and one 32-bits AHB slave ,they are point-to-point AXI-lite architecture
 - For each interconnect with AXI/AHB/APB composite bus, clocks for AXI/AHB/APB domains are always synchronous, and different integer ratio is supported for them.
 - Flexible different QoS solution to improve the utility of bus bandwidth
- Interrupt Controller
 - Support 3 PPI interrupt source and 76 SPI interrupt sources input from different components inside RK3168
 - Support 16 software-triggered interrupts
 - Input interrupt level is fixed , only high-level sensitive
 - Two interrupt outputs (nFIQ and nIRQ) separatelyfor each Cortex-A9, both are low-level sensitive
 - Support different interrupt priority for each interrupt source, and they are always software-programmable
- DMAC
 - Micro-code programming based DMA
 - The specific instruction set provides flexibility for programming DMA transfers
 - Linked list DMA function is supported to complete scatter-gather transfer
 - Support internal instruction cache
 - Embedded DMA manager thread
 - Support data transfer types with memory-to-memory, memory-to-peripheral, peripheral-to-memory
 - Signals the occurrence of various DMA events using the interrupt output signals
 - Mapping relationship between each channel and different interrupt outputs is software-programmable
 - Two embedded DMA controller , DMAC0 is for cpu system, DMAC1 is for peri system
 - DMAC0 features:
 - ◆ 6 channels totally
 - ◆ 11 hardware request from peripherals
 - ◆ 2 interrupt output
 - ◆ Dual APB slave interface for register config, designated as secure and non-secure
 - ◆ Support trustzone technology and programmable secure state for

- each DMA channel
- DMAC1 features:
 - ◆ 7 channels totally
 - ◆ 13 hardware request from peripherals
 - ◆ 2 interrupt output
 - ◆ Not support trustzone technology
- Security system
 - Support trustzone technology for the following components inside RK3168
 - ◆ Cortex-A9, support security and non-security mode, switch by software
 - ◆ DMAC0, support some dedicated channels work only in security mode
 - ◆ eFuse, only accessed by Cortex-A9 in security mode
 - ◆ Internal memory , part of space is addressed only in security mode, detailed size is software-programmable together with TZMA(trustzone memory adapter) and TZPC(trustzone protection controller)

1.1.6 Video CODEC

- Shared internal memory and bus interface for video decoder and encoder^②
- Video Decoder
 - Real-time video decoder of MPEG-1, MPEG-2, MPEG-4,H.263, H.264 , RV , VP6/VP8 , Sorenson Spark
 - Error detection and concealment support for all video formats
 - Output data format is YUV420 semi-planar, and YUV400(monochrome) is also supported for H.264
 - H.264 up to HP level 4.2 : 1080p@60fps (1920x1088)^③
 - MPEG-4 up to ASP level 5 : 1080p@60fps (1920x1088)
 - MPEG-2 up to MP : 1080p@60fps (1920x1088)
 - MPEG-1 up to MP : 1080p@60fps (1920x1088)
 - H.263 : 576p@60fps (720x576)
 - Sorenson Spark : 1080p@60fps (1920x1088)
 - RV8/RV9/RV10 : 1080p@60fps (1920x1088)
 - VP6/VP8 : 1080p@60fps (1920x1088)
 - For H.264, Image cropping not supported
 - For MPEG-4,GMC(global motion compensation) not supported
 - For MPEG-4 SP/H.263/Sorenson spark, using a modified H.264 in-loop filter to implement deblocking filter in post-processor unit
- Video Encoder
 - Support video encoder for H.264 ([BP@level4.0](#), [MP@level4.0](#), [HP@level4.0](#)), MVC and VP8
 - Only support I and P slices, not B slices
 - Support error resilience based on constrained intra prediction and slices
 - Input data format :
 - ◆ YCbCr 4:2:0 planar
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbYCr 4:2:2
 - ◆ CbYCrY 4:2:2 interleaved
 - ◆ RGB444 and BGR444
 - ◆ RGB555 and BGR555
 - ◆ RGB565 and BGR565

- ◆ RGB888 and BRG888
- ◆ RGB101010 and BRG101010
- Image size is from 96x96 to 1920x1088(Full HD)
- Maximum frame rate is up to 30fps@1920x1080®
- Bit rate supported is from 10Kbps to 20Mbps

1.1.7 JPEG CODEC

- JPEG decoder
 - Input JPEG file : YCbCr 4:0:0, 4:2:0, 4:2:2, 4:4:0, 4:1:1 and 4:4:4 sampling formats
 - Output raw image : YCbCr 4:0:0, 4:2:0, 4:2:2, 4:4:0, 4:1:1 and 4:4:4 semi-planar
 - Decoder size is from 48x48 to 8176x8176(66.8Mpixels)
 - Maximum data rate® is up to 76million pixels per second
- JPEG encoder
 - Input raw image :
 - ◆ YCbCr 4:2:0 planar
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbYCr 4:2:2
 - ◆ CbYCrY 4:2:2 interleaved
 - ◆ RGB444 and BGR444
 - ◆ RGB555 and BGR555
 - ◆ RGB565 and BGR565
 - ◆ RGB888 and BRG888
 - ◆ RGB101010 and BRG101010
 - Output JPEG file : JFIF file format 1.02 or Non-progressive JPEG
 - Encoder image size up to 8192x8192(64million pixels) from 96x32
 - Maximum data rate® up to 90million pixels per second

1.1.8 Image Enhancement

- Image Post-Processor(embedded inside video decoder)
 - Combined with HD video decoder and JPEG decoder, post-processor can read input data directly from decoder output to reduce bus bandwidth
 - Also work as a stand-alone mode, its input data is from a camera interface or other image data stored in external memory
 - Input data format :
 - ◆ any format generated by video decoder in combined mode
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbCr 4:2:0 planar
 - ◆ YCbYCr 4:2:2
 - ◆ YCrYCb 4:2:2
 - ◆ CbYCrY 4:2:2
 - ◆ CrYCbY 4:2:2
 - Output data format:
 - ◆ YCbCr 4:2:0 semi-planar
 - ◆ YCbYCr 4:2:2
 - ◆ YCrYCb 4:2:2
 - ◆ CbYCrY 4:2:2
 - ◆ CrYCbY 4:2:2
 - ◆ Fully configurable ARGB channel lengths and locations inside 32bits, such as ARGB8888,RGB565,ARGB4444 etc.
 - Input image size:

- ◆ Combined mode : from 48x48 to 8176x8176 (66.8Mpixels)
- ◆ Stand-alone mode : width from 48 to 8176, height from 48 to 8176, and maximum size limited to 16.7Mpixels
- ◆ Step size is 16 pixels
- Output image size: from 16x16 to 1920x1088 (horizontal step size 8, vertical step size 2)
- Support image up-scaling :
 - ◆ Bicubic polynomial interpolation with a four-tap horizontal kernel and a two-tap vertical kernel
 - ◆ Arbitrary non-integer scaling ratio separately for both dimensions
 - ◆ Maximum output width is 3x input width
 - ◆ Maximum output height is 3x input height
- Support image down-scaling:
 - ◆ Arbitrary non-integer scaling ratio separately for both dimensions
 - ◆ Unlimited down-scaling ratio
- Support YUV to RGB color conversion, compatible with BT.601-5, BT.709 and user definable conversion coefficient
- Support dithering (2x2 ordered spatial dithering for 4,5,6bit RGB channel precision)
- Support programmable alpha channel and alpha blending operation with the following overlay input formats:
 - ◆ 8bit alpha +YUV444, big endian channel order with AYUV8888
 - ◆ 8bit alpha +24bit RGB, big endian channel order with ARGB8888
- Support RGB image contrast / brightness / color saturation adjustment
- Support image cropping & digital zoom only for JPEG or stand-alone mode
- Support picture in picture
- Support image rotation (horizontal flip, vertical flip, rotation 90,180 or 270 degrees)
- Image Post-Processor (IPP)(standalone)
 - memory to memory mode
 - input data format and size
 - ◆ RGB888 : 16x16 to 8191x8191
 - ◆ RGB565 : 16x16 to 8191x8191
 - ◆ YUV422/YUV420 : 16x16 to 8190x8190
 - ◆ YUV444 : 16x16 to 8190x8190
 - pre scaler
 - ◆ integer down-scaling(ratio: 1/2, 1/3, 1/4, 1/5, 1/6, 1/7, 1/8) with linear filter
 - ◆ deinterlace(up to 1080i) to support YUV422&YUV420 input format
 - post scaler
 - ◆ down-scaling with 1/2 ~ 1 arbitrary non-integer ratio
 - ◆ up-scaling with 1~4 arbitrary non-integer ratio
 - ◆ 4-tap vertical, 2-tap horizontal filter
 - ◆ The max output image width of post scaler is 4096
 - Support rotation with 90/180/270 degrees and x-mirror,y-mirror

1.1.9 Graphics Engine

- 3D Graphics Engine :
 - Max frequency : 400MHz@0.9V(Worst Case)
 - Advanced Shader Feature Set – in excess of Microsoft VS3.0, PS3.0 & OGL2.0

- Industry standard API support – Direct3D Mobile, OGL-ES 1.1 and 2.0, OpenVG 1.1, OpenMax
- Universal Scalable Shader Engine – multi-threaded engine incorporating Pixel and Vertex Shader functionality
- Fine grained task switching, load balancing and power management
- Advanced geometry DMA driven operation for minimum CPU interaction
- Programmable high quality image anti-aliasing
- Provide MMU and L2 Cache with 64KB size
- Max polythroughput: 33.3M triangles/s @400MHz;
- Max Fillrate-1 texture: 800M pixels/s @400MHz;
- Max Fillrate-2 texture: 400M pixels/s @400MHz;
- 2D Graphics Engine :
 - Max frequency : 400MHz@0.9V(Worst Case)
 - Pixel rate : 500Mpix/s without scale , 250Mpix/s with bilinear scale , 125Mpix/s with bicubic scale.
 - Bit Blit with Stretch Blit ,Simple Blit and Filter Blit
 - Color fill with gradient fill , and pattern fill
 - Line drawing with anti-aliasing and specified width
 - High-performance stretch and shrink
 - Monochrome expansion for text rendering
 - ROP2,ROP3,ROP4 full alpha blending and transparency
 - Alpha blending modes including Java 2 Porter-Duff compositing blending rules , chroma key, and pattern mask
 - 8K x 8K raster 2D coordinate system
 - Arbitrary degrees rotation with anti-aliasing on every 2D primitive
 - Programmable bicubic filter to support image scaling
 - Blending, scaling and rotation are supported in one pass for stretch blit
 - Source format :
 - ◆ ABGR8888 , XBGR888 , ARGB8888, XRGB888
 - ◆ RGB888, RGB565
 - ◆ RGBA5551, RGBA4444
 - ◆ YUV420 planar , YUV420 semi-planar
 - ◆ YUV422 planar , YUV422 semi-planar
 - ◆ BPP8, BPP4 , BPP2 , BPP1
 - Destination formats :
 - ◆ ABGR8888 , XBGR888 , ARGB8888, XRGB888
 - ◆ RGB888, RGB565
 - ◆ RGBA5551, RGBA4444
 - ◆ YUV420 planar,YUV420 semi-planar only in filter and pre-scale

mode

- ◆ YUV422 planar , YUV422 semi-planar only in filter and pre-scale mode

1.1.10 Video IN/OUT

- Camera Interface
 - Support up to 5M pixels
 - 8bits CCIR656(PAL/NTSC) interface
 - 8bits/10bits/12bits raw data interface
 - YUV422 data input format with adjustable YUV sequence
 - YUV422,YUV420 output format with separately Y and UV space
 - Support picture in picture (PIP)
 - Support simple image effects such as Arbitrary(sepia), Negative, Art freeze, Embossing etc.
 - Support static histogram statistics and white balance statistics
 - Support image crop with arbitrary windows
 - Support scale up/down from 1/8 to 8 with arbitrary non-integer ratio
- Display Interface
 - 2 independent display controller
 - Support LCD or TFT interfaces up to 1920x1080
 - Parallel RGB LCD Interface :
 - RGB888(24bits),RGB666(18bits),RGB565(15bits)
 - Serial RGB LCD Interface: 3x8bits with RGB delta support, 3x8bits followed by dummy data, 16bits followed by 8bits
 - MCU LCD interface : i-8080 with up to 24bits RGB
 - 4 display layers :
 - ◆ One background layer with programmable 24bits color
 - ◆ One video layer (win0)
 - RGB888, ARGB888, RGB565, YUV422, YUV420, AYUV
 - maximum resolution is 1920x1080
 - 1/8 to 8 scaling up/down engine with arbitrary non-integer ratio
 - 256 level alpha blending
 - Support transparency color key
 - Support 3D display
 - ◆ One video layer (win1)
 - RGB888, ARGB888, RGB565, YUV422, YUV420, AYUV
 - maximum resolution is 1920x1080
 - 1/8 to 8 scaling up/down engine with arbitrary non-integer ratio
 - 256 level alpha blending
 - Support transparency color key
 - ◆ One OSD layer(win2)
 - RGB888, ARGB888, RGB565, 1/2/4/8BPP
 - 256 level alpha blending
 - transparency color key
 - ◆ Hardware cursor(HWC)
 - 32x32x2bpp
 - 3-color and transparent mode
 - 2-color + transparency + tran_invert mode
 - 16 level alpha blending
 - 3 x 256 x 8 bits display LUTs
 - Win0 and Win1 layer overlay exchangeable

- Support color space conversion :
YUV2RGB(rec601-mpeg/rec601-jpeg/rec709) and RGB2YUV
- Support replication(16bits to 24bits) and dithering(24bits to 16bits/18bits) operation
- Blank and black display
- Standby mode

1.1.11 Audio Interface

- I2S/PCM with 2ch
 - Up to 2 channels (2xTX, 2xRX)
 - Audio resolution from 16bits to 32bits
 - Sample rate up to 192KHz
 - Provides master and slave work mode, software configurable
 - Support 3 I2S formats (normal , left-justified , right-justified)
 - Support 4 PCM formats(early , late1 , late2 , late3)
 - I2S and PCM mode cannot be used at the same time
- SPDIF
 - Audio resolution : 16bits/20bits/24bits
 - Software configurable sample rates (48KHz, 44.1KHz, 32KHz)
 - Stereo voice replay with 2 channels

1.1.12 Connectivity

- SDIO interface
 - Compatible with SDIO 3.0 protocol
 - Support FIFO over-run and under-run prevention by stopping card clock automatically
 - 4bits data bus widths
- High-speed ADC stream interface
 - Support single-channel 8bits/10bits interface
 - DMA-based and interrupt-based operation
 - Support 8bits TS stream interface
 - Support PID filter operation
 - ◆ Combined with high-speed ADC interface to implement filter from original TS data
 - ◆ Provide PID filter up to 64 channels PID simultaneously
 - ◆ Support sync-byte detection in transport packet head
 - ◆ Support packet lost mechanism in condition of limited bandwidth
- MAC 10/100MEthernet Controller
 - IEEE802.3u compliant Ethernet Media Access Controller(MAC)
 - Support only RMII(Reduced MII) mode
 - 10Mbps and 100Mbps compatible
 - Automatic retry and automatic collision frame deletion
 - Full duplex support with flow-control
 - Address filtering(broadcast, multicast, logical, physical)
- SPI Controller
 - 2 on-chip SPI controller inside RK3168
 - Support serial-master and serial-slave mode, software-configurable
 - DMA-based or interrupt-based operation
 - Embedded two 32x16bits FIFO for TX and RX operation respectively
 - Support 2 chip-selects output in serial-master mode

- Uart Controller
 - 4 on-chip uart controller inside RK3168
 - DMA-based or interrupt-based operation
 - For UART1/UART2/UART3, Embedded two 32Bytes FIFO for TX and RX operation respectively
 - For UART0, two 64Bytes FIFOs are embedded for TX/RX operation
 - Support 5bit,6bit,7bit,8bit serial data transmit or receive
 - Standard asynchronous communication bits such as start,stop and parity
 - Support different input clock for uart operation to get up to 4Mbps or other special baud rate
 - Support non-integer clock divides for baud clock generation
 - Auto flow control mode is only for UART0, UART1, UART3
- I2C controller
 - 5 on-chip I2C controller in RK3168
 - Multi-master I2C operation
 - Support 7bits and 10bits address mode
 - Software programmable clock frequency and transfer rate up to 400Kbit/s in the fast mode
 - Serial 8bits oriented and bidirectional data transfers can be made at up to 100Kbit/s in the standard mode
- GPIO
 - 4 groups of GPIO (GPIO0~GPIO3,) , 32 GPIOs per group, totally have 128 GPIOs
 - All of GPIOs can be used to generate interrupt to Cortex-A9
 - GPIO0 can be used to wakeup system from stop/sleep/power-off mode
 - All of pullup GPIOs are software-programmable for pullup resistor or not
 - All of pulldown GPIOs are software-programmable for pulldown resistor or not
 - All of GPIOs are always in input direction in default after power-on-reset
 - The drive strength for all of GPIOs is software-programmable
- USB Host2.0
 - Compatible with USB Host2.0 specification
 - Supports high-speed(480Mbps), full-speed(12Mbps) and low-speed(1.5Mbps) mode
 - Provides 16 host mode channels
 - Support periodic out channel in host mode
- USB OTG2.0
 - Compatible with USB OTG2.0 specification
 - Supports high-speed(480Mbps), full-speed(12Mbps) and low-speed(1.5Mbps) mode
 - Support up to 9 device mode endpoints in addition to control endpoint 0
 - Support up to 6 device mode IN endpoints including control endpoint 0
 - Endpoints 1/3/5/7 can be used only as data IN endpoint
 - Endpoints 2/4/6 can be used only as data OUT endpoint
 - Endpoints 8/9 can be used as data OUT and IN endpoint
 - Provides 9 host mode channels
- Compliant with the USB2.0 Specification and Enhanced Host Controller

Interface Specification 2.0

- Built-in one 840x35 bits FIFO
- Internal DMA with scatter/gather function

1.1.13 Others

- SAR-ADC(Successive Approximation Register)
 - 3-channel single-ended 10-bit SAR analog-to-digital converter
 - Conversion speed range is up to 1 MSPS
 - SAR-ADC clock must be less than 1MHz
 - DNL is less than ± 1 LSB , INL is less than ± 2.0 LSB
 - Power down current is about 0.5uA for analog and digital logic
 - Power supply is 1.8V ($\pm 10\%$) for analog interface
- eFuse
 - 256bits (32x8) high-density electrical Fuse
 - Programming condition : VQPS must be 1.5($\pm 10\%$)
 - Program time is about 10us($\pm 1\mu s$)
 - Read condition : VQPS must be 0V
 - Support standby mode
- Operation Temperature Range
 - -40°C to +85°C
- Operation Voltage Range
 - Core supply: 1.0V ($\pm 10\%$)
 - IO supply : 3.3V or 2.5V or 1.8V ($\pm 10\%$)
- Process
 - GlobalFoundry28nmSLP
- Package Type
 - TFBGA453LD (body: 19mm x 19mm ; ball size : 0.4mm ; ball pitch : 0.8mm)
- Power
 - TBA

Notes :^①: DDR3/LPDDR2 are not used simultaneously as well as async and sync ddr nand flash

^②: In RK3168, Video decoder and encoder are not used simultaneously because of shared internal buffer

^③: Actual maximum frame rate will depend on the clock frequency and system bus performance

^④: Actual maximum data rate will depend on the clock frequency and JPEG compression rate

1.2 Block Diagram

The following diagram shows the basic block diagram for RK3168.

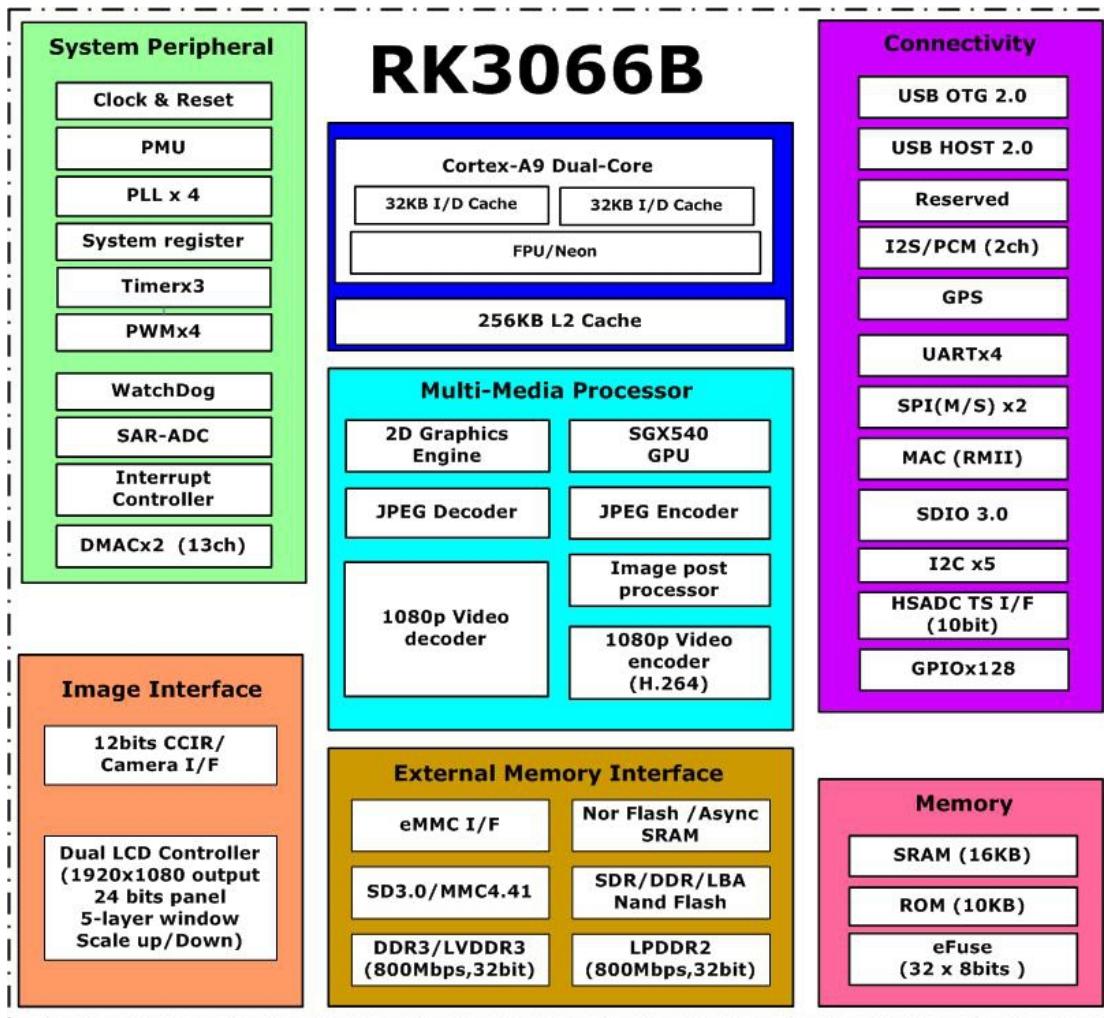


Fig. 1- 1 RK3168 Block Diagram

1.3 Pin Description

In this chapter, the pin description will be divided into two parts, one is all power/ground descriptions in Table 1-1, include analog power/ground, another is all the function signals descriptions in Table 1-2, also include analog power/ground.

1.3.1 RK3168 power/ground IO descriptions

Table 1- 1 RK3168 Power/Ground IO informations

Group	Ball #	Min(V)	Typ(V)	Max(V)	Descriptions
GND	C2,D4,D7,D10,D13,D16,D19,C2 1,E21,G9,G14,H8,H9,H10,H11,H 12,H13,H14,H15,H16,J8,J9,J10, J11,J12,J13,J14,J15,J16,K8,K9, K10,K11,K12,K13,K14,K15,K16, L8,L9,L10,L11,L12,L13,L14,L15, L16,M8,M9,M10,M11,M12,M13, M14,M15,M16,N8,N9,N10,N11,N 12,N13,N14,N15,N16,N17,P7,P8 ,P9,P10,P11,P12,P13,P14,P15, P16,P17,R7,R8,R9,R10,R11,R1 2,R13,R14,R15,R16,T7,T8,T9,T 10,T11,T12,T13,T14,T15,T16,V3 ,AA8,AA14,AA16,AA18	N/A	N/A	N/A	Internal Core Ground and Digital IO Ground
AVDD	N5,N6,P5,P6,T5,T6,U5, U6,V5,V7,U8,U9,U10,V8,V10	0.9 TBD	1.0 TBD	1.1 TBD	Internal CPU Power (@ cpu frequency <= 1GHz) Internal CPU Power (@ cpu frequency <= 1.5GHz)
CVDD	G8,G10,G16,G18,H17,J17,H7,N 7,L17,L18,M17,P18,R17,T17	0.9	1.0	1.1	Internal Core Logic Power
PVDD	W14	0.9	1.0	1.1	Internal PMU Domain Logic Power
PVCC_3V3	W13	3	3.3	3.6	PMU Domain Digital IO Power
VCCIO0	K17	3	3.3	3.6	Digital GPIO Power
VCCIO1	H18	3	3.3	3.6	
LCD0_VCC0	K7	3 1.62	3.3 1.8	3.6 1.98	LCD0 Digital IO Power
LCD0_VCC1	J7	3 1.62	3.3 1.8	3.6 1.98	
LCD1_VCC	L7	3 1.62	3.3 1.8	3.6 1.98	LCD1 Digital IO Power
CIF_VCC	M7	3 1.62	3.3 1.8	3.6 1.98	Camera Digital IO Power

FLASH_VCC	N18	3 1.62	3.3 1.8	3.6 1.98	Nand Flash Digital IO Power
AP0_VCC	V17	3 1.62	3.3 1.8	3.6 1.98	UART0/SDIO/MAC for Mobile phone Digital IO Power
AP1_VCC	U18	3 1.62	3.3 1.8	3.6 1.98	UART1/SPI0/I2S/I2C4 for Mobile phone Digital IO Power
MVDD	F7,F8,F10,F11,F13,F14,F16,F17	1.425 1.14	1.5 1.2	1.575 1.30	DDR3 Digital IO Power LPDDR2 Digital IO Power
APLL_AVSS	U11	N/A	N/A	N/A	ARM PLL Analog Ground
APLL_AVDD	V11	0.9	1.0	1.1	ARM PLL Analog Power
DPLL_AVSS	U13	N/A	N/A	N/A	DDR PLL Analog Ground
DPLL_AVDD	V14	0.9	1.0	1.1	DDR PLL Analog Power
CGPLL_AVSS	U12	N/A	N/A	N/A	CODEC/GENERAL PLL Analog Ground
CGPLL_1V0	V13	0.9	1.0	1.1	CODEC/GENERAL PLL Analog Power
ADCVDD_1V8	K18	1.62	1.8	1.98	SAR-ADC Analog Power
USBDVDD_1V0	U14	0.9	1.0	1.1	USB OTG2.0/Host2.0 Digital Power
USBVDD_1V8	V16	1.62	1.8	1.98	USB OTG2.0/Host2.0 Analog Power
USBVDD_3V3	U15	3.069	3.3	3.63	USB OTG2.0/Host2.0 Analog Power
EFUSE_VDDQ	Y10	1.35	1.5	1.65	eFuse IO Digital Power

1.3.2 RK3168 function IO descriptions

Table 1- 2RK3168 IO descriptions

Pad#	Ball#	func0	func1	func2	func3	Pad type [®]	Current [®]	Pull	Reset State [®]	Power Supply [®]
Left										
LCDC0_DATA[5]	G6	LCDC0_DATA[5]				O	8	N/A	O	LCDC0_VCC0 LCDC0_VCC1
LCDC0_DATA[6]	F5	LCDC0_DATA[6]				O	8	N/A	O	
LCDC0_DATA[7]	F4	LCDC0_DATA[7]				O	8	N/A	O	
LCDC0_DATA[8]	F3	LCDC0_DATA[8]				O	8	N/A	O	
LCDC0_DATA[9]	F2	LCDC0_DATA[9]				O	8	N/A	O	
LCDC0_DATA[10]	G5	LCDC0_DATA[10]				O	8	N/A	O	
LCDC0_DATA[11]	G4	LCDC0_DATA[11]				O	8	N/A	O	
LCDC0_DATA[12]	G3	LCDC0_DATA[12]				O	8	N/A	O	
LCDC0_DATA[13]	G2	LCDC0_DATA[13]				O	8	N/A	O	
LCDC0_DATA[14]	G1	LCDC0_DATA[14]				O	8	N/A	O	
LCDC0_DATA[15]	H6	LCDC0_DATA[15]				O	8	N/A	O	
LCDC0_DATA[16]	H5	LCDC0_DATA[16]				O	8	N/A	O	
LCDC0_DATA[17]	H4	LCDC0_DATA[17]				O	8	N/A	O	
LCDC0_DATA[18]	H3	LCDC0_DATA[18]				O	8	N/A	O	
LCDC0_DATA[19]	H2	LCDC0_DATA[19]				O	8	N/A	O	
LCDC0_DATA[20]	H1	LCDC0_DATA[20]				O	8	N/A	O	
LCDC0_DATA[21]	K1	LCDC0_DATA[21]				O	8	N/A	O	
LCDC0_DATA[22]	J3	LCDC0_DATA[22]				O	8	N/A	O	
LCDC0_DATA[23]	J2	LCDC0_DATA[23]				O	8	N/A	O	
GPIO2_A[0]	K6	GPIO2_A[0]	lcdd1_data0	smc_data0	trace_data0	I/O	8	down	I	LCD1_VCC
GPIO2_A[1]	K5	GPIO2_A[1]	lcdd1_data1	smc_data1	trace_data1	I/O	8	down	I	
GPIO2_A[2]	L4	GPIO2_A[2]	lcdd1_data2	smc_data2	trace_data2	I/O	8	down	I	
GPIO2_A[3]	K4	GPIO2_A[3]	lcdd1_data3	smc_data3	trace_data3	I/O	8	down	I	
GPIO2_A[4]	K3	GPIO2_A[4]	lcdd1_data4	smc_data4	trace_data4	I/O	8	down	I	
GPIO2_A[5]	K2	GPIO2_A[5]	lcdd1_data5	smc_data5	trace_data5	I/O	8	down	I	
GPIO2_A[6]	L6	GPIO2_A[6]	lcdd1_data6	smc_data6	trace_data6	I/O	8	down	I	
GPIO2_A[7]	L5	GPIO2_A[7]	lcdd1_data7	smc_data7	trace_data7	I/O	8	down	I	
GPIO2_B[0]	M3	GPIO2_B[0]	lcdd1_data8	smc_data8	trace_data8	I/O	8	down	I	
GPIO2_B[1]	L3	GPIO2_B[1]	lcdd1_data9	smc_data9	trace_data9	I/O	8	down	I	
GPIO2_B[2]	L2	GPIO2_B[2]	lcdd1_data10	smc_data10	trace_data10	I/O	8	down	I	
GPIO2_B[3]	L1	GPIO2_B[3]	lcdd1_data11	smc_data11	trace_data11	I/O	8	down	I	
GPIO2_B[4]	M2	GPIO2_B[4]	lcdd1_data12	smc_data12	trace_data12	I/O	8	down	I	
GPIO2_B[5]	N4	GPIO2_B[5]	lcdd1_data13	smc_data13	trace_data13	I/O	8	down	I	
GPIO2_B[6]	P4	GPIO2_B[6]	lcdd1_data14	smc_data14	trace_data14	I/O	8	down	I	
GPIO2_B[7]	N3	GPIO2_B[7]	lcdd1_data15	smc_data15	trace_data15	I/O	8	down	I	
GPIO2_C[0]	N2	GPIO2_C[0]	lcdd1_data16	smc_addr0	trace_clk	I/O	8	down	I	
GPIO2_C[1]	N1	GPIO2_C[1]	lcdd1_data17	smc_addr1	trace_ctl	I/O	8	down	I	
GPIO2_C[2]	P1	GPIO2_C[2]	lcdd1_data18	smc_addr2		I/O	8	down	I	

GPIO2_C[3]	P2	GPIO2_C[3]	lcdc1_data19	smc_addr3		I/O	8	down	I
GPIO2_C[4]	P3	GPIO2_C[4]	lcdc1_data20	smc_addr4		I/O	8	down	I
GPIO2_C[5]	R3	GPIO2_C[5]	lcdc1_data21	smc_addr5		I/O	8	down	I
GPIO2_C[6]	R2	GPIO2_C[6]	lcdc1_data22	smc_addr6		I/O	8	down	I
GPIO2_C[7]	T4	GPIO2_C[7]	lcdc1_data23	smc_addr7		I/O	8	down	I
GPIO2_D[0]	T1	GPIO2_D[0]	lcdc1_dclk	smc_csn0		I/O	12	down	I
GPIO2_D[1]	T2	GPIO2_D[1]	lcdc1_den	smc_we_n		I/O	8	down	I
GPIO2_D[2]	T3	GPIO2_D[2]	lcdc1_hsync	smc_oe_n		I/O	8	down	I
GPIO2_D[3]	U1	GPIO2_D[3]	lcdc1_vsync	smc_adv_n		I/O	8	down	I
GPIO2_D[4]	U2	GPIO2_D[4]	smc_bls_n0			I/O	4	up	I
GPIO2_D[5]	U3	GPIO2_D[5]	smc_bls_n1			I/O	4	up	I
GPIO2_D[6]	U4	GPIO2_D[6]	smc_csn1			I/O	4	up	I
CIF_CLKIN	V2	CIF_CLKIN	hsadc_clkout	gps_clk		I/O	2	down	I
CIF_DATA[3]	W1	CIF_DATA[3]	hsadc_data1			I	2	down	I
CIF_DATA[4]	W2	CIF_DATA[4]	hsadc_data2			I	2	down	I
CIF_DATA[5]	W3	CIF_DATA[5]	hsadc_data3			I	2	down	I
CIF_DATA[6]	V4	CIF_DATA[6]	hsadc_data4			I	2	down	I
CIF_DATA[7]	Y3	CIF_DATA[7]	hsadc_data5			I	2	down	I
CIF_DATA[8]	Y4	CIF_DATA[8]	hsadc_data6			I	2	down	I
CIF_DATA[9]	W4	CIF_DATA[9]	hsadc_data7			I	2	down	I
CIF_VSYNC	AA3	CIF_VSYNC	ts_sync			I	2	down	I
CIF_HREF	AB2	CIF_HREF				I	2	down	I
CIF_DATA[2]	AB3	CIF_DATA[2]	hsadc_data0			I	2	down	I
GPIO3_B[3]	Y5	GPIO3_B[3]	cif_clkout			I/O	4	down	I
GPIO3_B[4]	AC2	GPIO3_B[4]	cif_data0	hsadc_data8		I/O	2	down	I
GPIO3_B[5]	AC1	GPIO3_B[5]	cif_data1	hsadc_data9		I/O	2	down	I
GPIO3_B[6]	AA4	GPIO3_B[6]	cif_data10	i2c3_sda		I/O	2	up	I
GPIO3_B[7]	AB4	GPIO3_B[7]	cif_data11	i2c3_scl		I/O	2	up	I
Bottom									
GPIO0_A[0]	AC4	GPIO0_A[0]				I/O	2	down	I
GPIO0_A[1]	Y6	GPIO0_A[1]				I/O	2	down	I
GPIO0_A[2]	AA5	GPIO0_A[2]				I/O	2	down	I
GPIO0_A[3]	W7	GPIO0_A[3]				I/O	2	down	I
GPIO0_A[4]	AA6	GPIO0_A[4]				I/O	2	up	I
GPIO0_A[5]	W6	GPIO0_A[5]				I/O	2	up	I
GPIO0_A[6]	W11	GPIO0_A[6]				I/O	2	up	I
GPIO0_A[7]	AC7	GPIO0_A[7]				I/O	2	up	I
CLK32K	AB5	CLK32K				I	2	down	I
NPOR	AC5	NPOR				I	2	N/A	I
GPIO0_B[0]	W8	GPIO0_B[0]				I/O	2	up	I
GPIO0_B[1]	AA7	GPIO0_B[1]				I/O	2	up	I
GPIO0_B[2]	AB6	GPIO0_B[2]				I/O	2	up	I
GPIO0_B[3]	Y8	GPIO0_B[3]				I/O	2	up	I

CORE_PWROFF	AB9	CORE_PWROFF				O	2	down	I	
CPU_PWROFF	AB7	CPU_PWROFF				O	2	down	I	
XIN24M	AB8	XIN24M				I		N/A	I	
XOUT24M	AC8	XOUT24M				O		N/A	I	
EFUSE_VQPS	Y10	EFUSE_VQPS				AP		N/A	NA	EFUSE
VDD2_APPLL	V11	1.0V				AP		N/A	NA	PLL Domain
VSS2_APPLL	U11	Analog Ground				AG		N/A	NA	
VDD1_APPLL	V11	1.0V				AP		N/A	NA	
VSS1_APPLL	U11	Analog Ground				AG		N/A	NA	
VSS1_CPLL	U12	Analog Ground				AG		N/A	NA	
VDD1_CPLL	V13	1.0V				AP		N/A	NA	
VSS2_CPLL	U12	Analog Ground				AG		N/A	NA	
VDD2_CPLL	V13	1.0V				AP		N/A	NA	
VDD2_GPLL	V13	1.0V				AP		N/A	NA	
VSS2_GPLL	U12	Analog Ground				AG		N/A	NA	
VDD1_GPLL	V13	1.0V				AP		N/A	NA	
VSS1_GPLL	U12	Analog Ground				AG		N/A	NA	
VDD2_DPLL	V14	1.0V				AP		N/A	NA	
VSS2_DPLL	U13	Analog Ground				AG		N/A	NA	
VDD1_DPLL	V14	1.0V				AP		N/A	NA	
VSS1_DPLL	U13	Analog Ground				AG		N/A	NA	
GPIO0_B[4]	AC10	GPIO0_B[4]				I/O	2	up	I	AP1_VCC
GPIO0_B[5]	AB10	GPIO0_B[5]				I/O	2	up	I	
GPIO0_B[6]	Y11	GPIO0_B[6]				I/O	2	up	I	
GPIO0_B[7]	AA11	GPIO0_B[7]				I/O	2	up	I	
GPIO1_A[4]	AA12	GPIO1_A[4]	uart1_sin	spi0_rxd		I/O	2	up	I	
GPIO1_A[5]	Y16	GPIO1_A[5]	uart1_sout	spi0_txd		I/O	2	down	I	
GPIO1_A[6]	AA13	GPIO1_A[6]	uart1_cts_n	spi0_clk		I/O	4	up	I	
GPIO1_A[7]	AB12	GPIO1_A[7]	uart1_rts_n	spi0_csn0		I/O	2	up	I	
GPIO1_B[7]	AB11	GPIO1_B[7]	spi0_csn1			I/O	2	up	I	
GPIO1_D[6]	AC11	GPIO1_D[6]	i2c4_sda			I/O	2	up	I	
GPIO1_D[7]	AA15	GPIO1_D[7]	i2c4_scl			I/O	2	up	I	
GPIO1_C[0]	Y13	GPIO1_C[0]	i2s_clk			I/O	4	down	I	
GPIO1_C[1]	W16	GPIO1_C[1]	i2s_sclk			I/O	2	down	I	
GPIO1_C[2]	AC19	GPIO1_C[2]	i2s_lrck_rx			I/O	2	down	I	
GPIO1_C[3]	Y14	GPIO1_C[3]	i2s_lrck_tx			I/O	2	down	I	
GPIO1_C[4]	AB13	GPIO1_C[4]	i2s_sdi			I/O	2	down	I	
GPIO1_C[5]	AC13	GPIO1_C[5]	i2s_sdo			I/O	2	down	I	
OTG_ID	Y17	OTG_ID				A		N/A	NA	USB_OTG Domain
OTG_DVDD	U14	OTG_DVDD				DP		N/A	NA	
OTG_VBUS	AA17	OTG_VBUS				A		N/A	NA	
OTG_VDD330	U15	OTG_VDD330				AP		N/A	NA	
OTG_DP	AC14	OTG_DP				A		N/A	NA	

OTG_DM	AB14	OTG_DM				A		N/A	NA
OTG_RKELVIN	AB15	OTG_RKELVIN				A		N/A	NA
OTG_VDD180	V16	OTG_VDD180				AP		N/A	NA
HOST_DVDD	U14	HOST_DVDD				DP		N/A	NA
HOST_VDD330	U15	HOST_VDD330				AP		N/A	NA
HOST_DP	AC16	HOST_DP				A		N/A	NA
HOST_DM	AB16	HOST_DM				A		N/A	NA
HOST_RKELVIN	AC17	HOST_RKELVIN				A		N/A	NA
HOST_VDD180	V16	HOST_VDD180				AP			NA
FLASH_RDY	W17	FLASH_RDY				I/O	4	up	I
FLASH_WP	Y18	FLASH_WP	emmc_pwr_en			O	4	down	I
FLASH_RDN	AB19	FLASH_RDN				O	8	up	O
FLASH_ALE	U19	FLASH_ALE				O	4	down	O
FLASH_CLE	W18	FLASH_CLE				O	4	down	O
Right									
FLASH_WRN	AA19	FLASH_WRN				O	8	up	O
FLASH_CSN	Y19	FLASH_CSN				O	4	up	O
GPIO0_D[1]	Y20	GPIO0_D[1]	flash_csn1			I/O	4	up	I
GPIO0_D[2]	AA22	GPIO0_D[2]	flash_csn2	emmc_cmd		I/O	4	up	I
GPIO0_D[3]	AA20	GPIO0_D[3]	flash_csn3	emmc_rstin_out		I/O	4	up	I
GPIO0_D[0]	AB20	GPIO0_D[0]	flash_dqs	emmc_clkout		I/O	8	down	I
FLASH_DATA[0]	AC20	FLASH_DATA[0]	emmc_data0			I/O	8	down	I
FLASH_DATA[1]	AB21	FLASH_DATA[1]	emmc_data1			I/O	8	down	I
FLASH_DATA[2]	AA21	FLASH_DATA[2]	emmc_data2			I/O	8	down	I
FLASH_DATA[3]	Y22	FLASH_DATA[3]	emmc_data3			I/O	8	down	I
FLASH_DATA[4]	AC22	FLASH_DATA[4]	emmc_data4			I/O	8	down	I
FLASH_DATA[5]	Y21	FLASH_DATA[5]	emmc_data5			I/O	8	down	I
FLASH_DATA[6]	AC23	FLASH_DATA[6]	emmc_data6			I/O	8	down	I
FLASH_DATA[7]	AB22	FLASH_DATA[7]	emmc_data7			I/O	8	down	I
GPIO0_C[0]	W22	GPIO0_C[0]	flash_data8			I/O	8	down	I
GPIO0_C[1]	W20	GPIO0_C[1]	flash_data9			I/O	8	down	I
GPIO0_C[2]	W21	GPIO0_C[2]	flash_data10			I/O	8	down	I
GPIO0_C[3]	Y23	GPIO0_C[3]	flash_data11			I/O	8	down	I
GPIO0_C[4]	AB23	GPIO0_C[4]	flash_data12			I/O	8	down	I
GPIO0_C[5]	V21	GPIO0_C[5]	flash_data13			I/O	8	down	I
GPIO0_C[6]	V19	GPIO0_C[6]	flash_data14			I/O	8	down	I
GPIO0_C[7]	W23	GPIO0_C[7]	flash_data15			I/O	8	down	I
GPIO3_A[2]	T19	GPIO3_A[2]	sdmmc0_clkout			I/O	4	down	I
GPIO3_A[3]	T18	GPIO3_A[3]	sdmmc0_cmd			I/O	4	up	I
GPIO3_A[4]	V20	GPIO3_A[4]	sdmmc0_data0			I/O	4	up	I
GPIO3_A[5]	U22	GPIO3_A[5]	sdmmc0_data1			I/O	4	up	I
GPIO3_A[6]	V22	GPIO3_A[6]	sdmmc0_data2			I/O	4	up	I
GPIO3_A[7]	U20	GPIO3_A[7]	sdmmc0_data3			I/O	4	up	I

GPIO0_D[4]	U23	GPIO0_D[4]	spi1_rxd			I/O	2	down	I
GPIO0_D[5]	R21	GPIO0_D[5]	spi1_txd			I/O	2	down	I
GPIO0_D[6]	T21	GPIO0_D[6]	spi1_clk			I/O	4	down	I
GPIO0_D[7]	T20	GPIO0_D[7]	spi1_csn0			I/O	2	down	I
GPIO1_B[2]	U21	GPIO1_B[2]	uart3_sin	gps_mag		I/O	2	up	I
GPIO1_B[3]	T22	GPIO1_B[3]	uart3_sout	gps_sig		I/O	2	down	I
GPIO1_B[4]	T23	GPIO1_B[4]	uart3_cts_n	gps_rfclk		I/O	2	up	I
GPIO1_B[5]	P21	GPIO1_B[5]	uart3_rts_n			I/O	2	up	I
GPIO1_B[0]	P20	GPIO1_B[0]	uart2_sin	jtag_tdi		I/O	2	up	I
GPIO1_B[1]	P19	GPIO1_B[1]	uart2_sout	jtag_tdo		I/O	2	down	I
GPIO3_D[4]	R22	GPIO3_D[4]	pwm1	jtag_trstn		I/O	2	down	I
GPIO3_D[5]	P22	GPIO3_D[5]	pwm2	jtag_tck	otg_drv_vbus	I/O	2	up	I
GPIO3_D[6]	P23	GPIO3_D[6]	pwm3	jtag_tms	host_drv_vbus	I/O	2	up	I
GPIO3_D[7]	N22	GPIO3_D[7]				I/O	2	down	I
GPIO3_D[3]	N23	GPIO3_D[3]	pwm0			I/O	2	down	I
GPIO1_B[6]	N20	GPIO1_B[6]	spdif_tx	spi1_csn1		I/O	2	down	I
GPIO3_A[0]	N19	GPIO3_A[0]	sdmmc0_rstn_out			I/O	2	up	I
GPIO3_A[1]	N21	GPIO3_A[1]	sdmmc0_pwr_en			I/O	2	down	I
GPIO3_B[0]	M21	GPIO3_B[0]	sdmmc0_detect_n			I/O	2	up	I
GPIO3_B[1]	M22	GPIO3_B[1]	sdmmc0_write_prt			I/O	2	down	I
GPIO1_A[0]	L20	GPIO1_A[0]	uart0_sin			I/O	2	up	I
GPIO1_A[1]	L19	GPIO1_A[1]	uart0_sout			I/O	2	down	I
GPIO1_A[2]	L21	GPIO1_A[2]	uart0_cts_n			I/O	2	up	I
GPIO1_A[3]	L23	GPIO1_A[3]	uart0_rts_n			I/O	2	up	I
GPIO3_C[0]	L22	GPIO3_C[0]	sdmmc1_cmd	rmii_tx_en		I/O	4	up	I
GPIO3_C[1]	K22	GPIO3_C[1]	sdmmc1_data0	rmii_txd1		I/O	4	up	I
GPIO3_C[2]	K23	GPIO3_C[2]	sdmmc1_data1	rmii_txd0		I/O	4	up	I
GPIO3_C[3]	K19	GPIO3_C[3]	sdmmc1_data2	rmii_rxd0		I/O	4	up	I
GPIO3_C[4]	K20	GPIO3_C[4]	sdmmc1_data3	rmii_rxd1		I/O	4	up	I
GPIO3_C[5]	K21	GPIO3_C[5]	sdmmc1_clkout	rmii_clkout	rmii_clkin	I/O	8	down	I
GPIO3_C[6]	J21	GPIO3_C[6]	sdmmc1_detect_n	rmii_rx_err		I/O	2	down	I
GPIO3_C[7]	J22	GPIO3_C[7]	sdmmc1_write_prt	rmii_crs_dvalid		I/O	2	down	I
GPIO3_D[0]	G23	GPIO3_D[0]	sdmmc1_pwr_en	mii_md		I/O	2	down	I
GPIO3_D[1]	H22	GPIO3_D[1]	sdmmc1_backend_pwr	mii_mdclk		I/O	2	down	I
GPIO3_D[2]	H23	GPIO3_D[2]	sdmmc1_int_n			I/O	2	down	I
DVDD_SARADC	K18	1.8V				P		N/A	NA
VDDA_SARADC	K18	1.8V				AP		N/A	NA
SARADC_AIN[2]	H19	SARADC_AIN[2]				A		N/A	NA
SARADC_AIN[1]	H20	SARADC_AIN[1]				A		N/A	NA
SARADC_AIN[0]	H21	SARADC_AIN[0]				A		N/A	NA
GPIO1_D[0]	G22	GPIO1_D[0]	i2c0_sda			I/O	2	up	I
GPIO1_D[1]	G21	GPIO1_D[1]	i2c0_scl			I/O	2	up	I
GPIO1_D[2]	G20	GPIO1_D[2]	i2c1_sda			I/O	2	up	I

GPIO1_D[3]	G19	GPIO1_D[3]	i2c1_scl			I/O	2	up	I
GPIO1_D[4]	F21	GPIO1_D[4]	i2c2_sda			I/O	2	up	I
GPIO1_D[5]	E20	GPIO1_D[5]	i2c2_scl			I/O	2	up	I
GPIO2_D[7]	F22	GPIO2_D[7]	test_clock_out			I/O	8	down	I
GPIO3_B[2]	F20	GPIO3_B[2]				I/O	2	down	I
JTAGSEL	F19	JTAGSEL				I/O	2	down	I
Top									
DDR_DQ[7]	E23	DDR_DQ[7]				I/O		N/A	I
DDR_DQ[6]	D23	DDR_DQ[6]				I/O		N/A	I
DDR_DQ[5]	B23	DDR_DQ[5]				I/O		N/A	I
DDR_DQ[4]	A23	DDR_DQ[4]				I/O		N/A	I
DDR_DQS[0]	B22	DDR_DQS[0]				I/O		N/A	I
DDR_DQS_B[0]	A22	DDR_DQS_B[0]				I/O		N/A	I
DDR_DQ[3]	D22	DDR_DQ[3]				I/O		N/A	I
DDR_DQ[2]	C22	DDR_DQ[2]				I/O		N/A	I
DDR_DQ[1]	D21	DDR_DQ[1]				I/O		N/A	I
DDR_DQ[0]	E22	DDR_DQ[0]				I/O		N/A	I
DDR_DM[0]	D20	DDR_DM[0]				I/O		N/A	I
DDR_VREF[0]	G13	DDR_VREF[0]				P		N/A	NA
DDR_DQ[23]	B21	DDR_DQ[23]				I/O		N/A	I
DDR_DQ[22]	B20	DDR_DQ[22]				I/O		N/A	I
DDR_DQ[21]	B18	DDR_DQ[21]				I/O		N/A	I
DDR_DQ[20]	C19	DDR_DQ[20]				I/O		N/A	I
DDR_DQS[2]	B19	DDR_DQS[2]				I/O		N/A	I
DDR_DQS_B[2]	A19	DDR_DQS_B[2]				I/O		N/A	I
DDR_DQ[19]	A20	DDR_DQ[19]				I/O		N/A	I
DDR_DQ[18]	A17	DDR_DQ[18]				I/O		N/A	I
DDR_DQ[17]	B17	DDR_DQ[17]				I/O		N/A	I
DDR_DQ[16]	C18	DDR_DQ[16]				I/O		N/A	I
DDR_DM[2]	C20	DDR_DM[2]				I/O		N/A	I
DDR_PZQ	G15	DDR_PZQ				I/O		N/A	I
DDR_ODT[1]	C17	DDR_ODT[1]				O		N/A	O
DDR_ODT[0]	D17	DDR_ODT[0]				O		N/A	O
DDR_ADDR[15]	A16	DDR_ADDR[15]				O		N/A	O
DDR_CMD_VREF_1	G13	DDR_CMD_VREF_1				P		N/A	NA
DDR_ADDR[14]	B16	DDR_ADDR[14]				O		N/A	O
DDR_ADDR[13]	C16	DDR_ADDR[13]				O		N/A	O
DDR_ADDR[12]	D18	DDR_ADDR[12]				O		N/A	O
DDR_ADDR[11]	B15	DDR_ADDR[11]				O		N/A	O
DDR_ADDR[10]	C15	DDR_ADDR[10]				O		N/A	O
DDR_ADDR[9]	E14	DDR_ADDR[9]				O		N/A	O
DDR_ADDR[8]	D14	DDR_ADDR[8]				O		N/A	O
DDR_ADDR[7]	C14	DDR_ADDR[7]				O		N/A	O

DDR_ADDR[6]	B14	DDR_ADDR[6]				O	N/A	O
DDR_ADDR[5]	A14	DDR_ADDR[5]				O	N/A	O
DDR_CK	B13	DDR_CK				O	N/A	O
DDR_CK_N	A13	DDR_CK_N				O	N/A	O
DDR_ADDR[4]	C13	DDR_ADDR[4]				O	N/A	O
DDR_ADDR[3]	E13	DDR_ADDR[3]				O	N/A	O
DDR_ADDR[2]	B12	DDR_ADDR[2]				O	N/A	O
DDR_ADDR[1]	C12	DDR_ADDR[1]				O	N/A	O
DDR_ADDR[0]	A11	DDR_ADDR[0]				O	N/A	O
DDR_BA[2]	B11	DDR_BA[2]				O	N/A	O
DDR_BA[1]	C11	DDR_BA[1]				O	N/A	O
DDR_BA[0]	D11	DDR_BA[0]				O	N/A	O
DDR_RASN	A10	DDR_RASN				O	N/A	O
DDR_CASN	B10	DDR_CASN				O	N/A	O
DDR_WEN	C10	DDR_WEN				O	N/A	O
DDR_CSN[1]	B9	DDR_CSN[1]				O	N/A	O
DDR_CSN[0]	A8	DDR_CSN[0]				O	N/A	O
DDR_CKE1	B8	DDR_CKE1				O	N/A	O
DDR_CKE0	C9	DDR_CKE0				O	N/A	O
DDR_RESET	E11	DDR_RESET				O	N/A	O
DDR_ISO_VREF_0	G12	DDR_ISO_VREF_0				P	N/A	NA
DDR_DQ[15]	C8	DDR_DQ[15]				I/O	N/A	I
DDR_DQ[14]	D8	DDR_DQ[14]				I/O	N/A	I
DDR_DQ[13]	E8	DDR_DQ[13]				I/O	N/A	I
DDR_DQ[12]	C7	DDR_DQ[12]				I/O	N/A	I
DDR_DQS[1]	B7	DDR_DQS[1]				I/O	N/A	I
DDR_DQS_B[1]	A7	DDR_DQS_B[1]				I/O	N/A	I
DDR_DQ[11]	E7	DDR_DQ[11]				I/O	N/A	I
DDR_DQ[10]	B6	DDR_DQ[10]				I/O	N/A	I
DDR_DQ[9]	C6	DDR_DQ[9]				I/O	N/A	I
DDR_DQ[8]	D6	DDR_DQ[8]				I/O	N/A	I
DDR_DM[1]	E6	DDR_DM[1]				I/O	N/A	I
DDR_VREF[1]	G13	DDR_VREF[1]				P	N/A	I
DDR_DQ[31]	A5	DDR_DQ[31]				I/O	N/A	I
DDR_DQ[30]	B5	DDR_DQ[30]				I/O	N/A	I
DDR_DQ[29]	C5	DDR_DQ[29]				I/O	N/A	I
DDR_DQ[28]	D5	DDR_DQ[28]				I/O	N/A	I
DDR_DQS[3]	B8	DDR_DQS[3]				I/O	N/A	I
DDR_DQS_B[3]	B4	DDR_DQS_B[3]				I/O	N/A	I
DDR_DQ[27]	C4	DDR_DQ[27]				I/O	N/A	I
DDR_DQ[26]	C3	DDR_DQ[26]				I/O	N/A	I
DDR_DQ[25]	B3	DDR_DQ[25]				I/O	N/A	I
DDR_DQ[24]	B2	DDR_DQ[24]				I/O	N/A	I

DDR_DM[3]	A2	DDR_DM[3]				I/O		N/A	I	
LCDC0_HSYNC	A1	LCDC0_HSYNC				O	8	N/A	O	LCDC0_VCC0
LCDC0_VSYNC	B1	LCDC0_VSYNC				O	8	N/A	O	
LCDC0_DCLK	D2	LCDC0_DCLK				O	12	N/A	O	
LCDC0_DEN	D3	LCDC0_DEN				O	8	N/A	O	
LCDC0_DATA[0]	D1	LCDC0_DATA[0]				O	8	N/A	O	
LCDC0_DATA[1]	E1	LCDC0_DATA[1]				O	8	N/A	O	
LCDC0_DATA[2]	E2	LCDC0_DATA[2]				O	8	N/A	O	
LCDC0_DATA[3]	E3	LCDC0_DATA[3]				O	8	N/A	O	
LCDC0_DATA[4]	E4	LCDC0_DATA[4]				O	8	N/A	O	

Notes :

①: Pad types : I = input , O = output , I/O = input/output (bidirectional) ,
 AP = Analog Power , AG = Analog Ground
 DP = Digital Power , DG = Digital Ground
 A = Analog

②: Output Drive Unit is mA , only Digital IO have drive value

③: Reset state : I = input without any pull resistor , O = output without any pull resistor ,

④: It is die location. For examples, "Left side" means that all the related IOs are always in left side of die

⑤: Power supply means that all the related IOs is in these IO power domain. If multiple powers is included, they are connected together in one IO power ring

1.3.3 IO pin name descriptions

This sub-chapter will focus on the detailed function description of every pins based on different interface.

Table 1-3 RK3168 IO function description list

Interface	Pin Name	Direction	Description
Misc	XIN24M	I	Clock input of 24MHz crystal
	XOUT24M	O	Clock output of 24MHz crystal
	CLK32K	I	Clock input of 32.768KHz
	CPU_PWROFF	O	Request signal to external PMIC for power down CPU subsystem with dual-core Cortex-A9
	CORE_PWROFF	O	Request signal to external PMIC for SoC Core logic w/o Cortex-A9 subsystem and PMU logic
	NPOR	I	Power on reset for chip

Interface	Pin Name	Direction	Description
Debug	JTAG_SEL	I	JTAG function select input
	TRST_N	I	JTAG interface reset input
	TCK	I	JTAG interface clock input/SWD interface clock input
	TDI	I	JTAG interface TDI input
	TMS	I/O	JTAG interface TMS input/SWD interface data out
	TDO	O	JTAG interface TDO output

Interface	Pin Name	Direction	Description
ETM Trace	trace_clk	O	Cortex-A9 ETM trace port clk
	trace_ctl	O	Cortex-A9 ETM trace port control
	trace_data _i (_i =0~15)	O	Cortex-A9 ETM trace port data

Interface	Pin Name	Direction	Description
SD/MMC Host Controller	sdmmc_clkout	O	sdmmc card clock.
	sdmmc_cmd	I/O	sdmmc card command output and response input.
	sdmmc_data _i (_i =0~3)	I/O	sdmmc card data input and output.
	sdmmc_detect_n	I	sdmmc card detect signal, a 0 represents presence of card.
	sdmmc_write_prt	I	sdmmc card write protect signal, a 1 represents write is protected.
	sdmmc_rstn_out	O	sdmmc card reset signal
	sdmmc_pwr_en	O	sdmmc card power-enable control signal

Interface	Pin Name	Direction	Description
SDIO Host Controller	sdio_clkout	O	sdio card clock.
	sdio_cmd	I/O	sdio card command output and response input.
	sdio_data i ($i=0\sim 3$)	I/O	sdio card data input and output.
	sdio_detect_n	I	sdio card detect signal, a 0 represents presence of card.
	sdio_write_prt	I	sdio card write protect signal, a 1 represents write is protected.
	sdio_pwr_en	O	sdio card power-enable control signal
	sdio_int_n	O	sdio card interrupt indication
	sdio_backend	O	the back-end power supply for embedded device

Interface	Pin Name	Direction	Description
eMMC Interface	emmc_clkout	O	emmc card clock.
	emmc_cmd	I/O	emmc card command output and response input.
	emmc_data i ($i=0\sim 7$)	I/O	emmc card data input and output.
	emmc_pwr_en	O	emmc card power-enable control signal
	emmc_rstn_out	O	emmc card reset signal

Interface	Pin Name	Direction	Description
DMC	CK	O	Active-high clock signal to the memory device.
	CK_B	O	Active-low clock signal to the memory device.
	CKE i ($i=0,1$)	O	Active-high clock enable signal to the memory device for two chip select.
	CS_B i ($i=0,1$)	O	Active-low chip select signal to the memory device. There are two chip select.
	RAS_B	O	Active-low row address strobe to the memory device.
	CAS_B	O	Active-low column address strobe to the memory device.
	WE_B	O	Active-low write enable strobe to the memory device.
	BA[2:0]	O	Bank address signal to the memory device.
	A[15:0]	O	Address signal to the memory device.
	DQ[31:0]	I/O	Bidirectional data line to the memory device.
	DQS[3:0]	I/O	Active-high bidirectional data strobes to the memory device.

	DQS_B[3:0]	I/O	Active-low bidirectional data strobes to the memory device.
	DM[3:0]	O	Active-low data mask signal to the memory device.
	ODTi ($i=0,1$)	O	On-Die Termination output signal for two chip select.
	RET_EN	I	Active-low retention latch enable input
	RESET	O	DDR3 reset signal to the memory device
	VREFi ($i=0,1,2,3$)	I/O	Reference Voltage input for three regions of DDR IO
	ZQ_PIN	I/O	ZQ calibration pad which connects 240ohm±1% resistor

Interface	Pin Name	Direction	Description
SMC	smc_oe_n	O	SMC output enable signal.
	smc_bls_n <i>i</i> ($i=0,1$)	O	SMC byte lane strobe signal for two bytes.
	smc_we_n	O	SMC write enable signal.
	smc_csn <i>i</i> ($i=0,1$)	O	SMC chip enable signal.
	smc_adv_n	O	SMC address valid signal in shared mode
	smc_addr <i>i</i> ($i=0\sim 7$)	O	SMC address signal.
	smc_data <i>i</i> ($i=0\sim 15$)	I/O	SMC directional data line to memory device.

Interface	Pin Name	Direction	Description
NandC	FLASH_WP	O	Flash write-protected signal
	FLASH_ALE	O	Flash address latch enable signal
	FLASH_CLE	O	Flash command latch enable signal
	FLASH_WRN	O	Flash write enable and clock signal
	FLASH_RDN	O	Flash read enable and write/read signal
	FLASH_DATA[i] ($i=0\sim 7$)	I/O	Low 8bits of flash data inputs/outputs signal
	flash_data <i>i</i> ($i=8\sim 15$)	I/O	High 8bits of flash data inputs/outputs signal
	flash_dqs	I/O	Flash data strobe signal
	FLASH_RDY	I	Flash ready/busy signal
	FLASH0_CSN	O	Flash chip enable signal for chip 0
	flash_csn <i>i</i> ($i=1\sim 3$)	O	Flash chip enable signal for chip i, $i=1\sim 3$

Interface	Pin Name	Direction	Description
HSADC Interface	hsadc_clkout	O	hsadc/tsi/gps reference clock
	hsadc_data <i>i</i> ($i=0\sim 9$)	I	hsadc($i=0\sim 9$)/tsi($i=0\sim 7$)/gps data($i=0,1$)
	ts_sync	I	ts synchronizer signal

Interface	Pin Name	Direction	Description
I2S/PCM Controller (2 channel)	i2s_clk	O	I2S/PCM1 clock source
	i2s_sclk	I/O	I2S/PCM1 serial clock
	i2s_lrck_rx	I/O	I2S/PCM1 left & right channel signal for receiving serial data, synchronous left & right channel in I2S mode and the beginning of a group of left & right channels in PCM mode
	i2s_sdi	I	I2S/PCM1 serial data input
	i2s_sdo	O	I2S/PCM1 serial data output
	i2s_lrck_tx	I/O	I2S/PCM1 left & right channel signal for transmitting serial data, synchronous left & right channel in I2S mode and the beginning of a group of left & right channels in PCM mode

Interface	Pin Name	Direction	Description
SPDIF transmitter	spdif_tx	O	spdif biphase data output

Interface	Pin Name	Direction	Description
SPI Controller	spix_clk($x=0,1$)	I/O	spi serial clock
	spix_csn(y= $0,1$)	I/O	spi chip select signal, low active
	spix_txd($x=0,1$)	O	spi serial data output
	spix_rxd($x=0,1$)	I	spi serial data input

Interface	Pin Name	Direction	Description
LCD0	LCD0_DCLK	O	LCD0 RGB interface display clock out, MCU i80 interface RS signal
	LCD0_VSYNC	O	LCD0 RGB interface vertical sync pulse, MCU i80 interface CSN signal
	LCD0_HSYNC	O	LCD0 RGB interface horizontal sync pulse, MCU i80 interface WEN signal
	LCD0_DEN	O	LCD0 RGB interface data enable, MCU i80 interface REN signal
	LCD0_DATA[23:0]	I/O	LCD0 data output/input

Interface	Pin Name	Direction	Description
LCD1	lcd1_dclk	O	LCD1 RGB interface display clock out, MCU i80 interface RS signal
	lcd1_vsync	O	LCD1 RGB interface vertical sync pulse, MCU i80 interface CSN signal
	lcd1_hsync	O	LCD1 RGB interface horizontal sync pulse, MCU

			i80 interface WEN signal
lcdc1_den	O		LCDC1 RGB interface data enable, MCU i80 interface REN signal
lcdc1_data[23:0]	I/O		LCDC1 data output/input

Interface	Pin Name	Direction	Description
Camera IF	CIF_CLKIN	I	Camera0 interface input pixel clock
	cif_clkout	O	Camera0 interface output work clock
	CIF_VSYNC	I	Camera0 interface vertical sync signal
	CIF_HREF	I	Camera0 interface horizontal sync signal
	cif_data[1:0]	I	Camera0 interface low 2-bit input pixel data
	CIF_DATAIN[9:2]	I	Camera0 interface middle 8-bit input pixel data
	cif_data[11:10]	I	Camera0 interface high 2-bit input pixel data

Interface	Pin Name	Direction	Description
RMII	rmii_clkout	O	RMII REC_CLK output
	rmii_clkin	I	RMII REF_CLK input
	rmii_tx_en	O	rmii transfer enable
	rmii_txd1	O	rmii transfer data
	rmii_txd0	O	rmii transfer data
	rmii_rx_err	I	rmii receive error
	rmii_crs_dvalid	I	rmii carrier sense / receive data valid input
	rmii_rxd1	I	rmii receive data
	rmii_rxd0	I	rmii receive data
	mii_md	I/O	mii management interface data
	mii_mdclk	O	mii management interface clock

Interface	Pin Name	Direction	Description
PWM	pwm3	O	Pulse Width Modulation output
	pwm2	O	Pulse Width Modulation output
	pwm1	O	Pulse Width Modulation output
	pwm0	O	Pulse Width Modulation output

Interface	Pin Name	Direction	Description
GPS	gps_rfclk	I	GPS reference clock
	gps_sig	I	GPS SIG input
	gps_mag	I	GPS MAG input

Interface	Pin Name	Direction	Description

I2C	i2c0_sda	I/O	I2C0 data
	i2c0_scl	I/O	I2C0 clock
	i2c1_sda	I/O	I2C1 data
	i2c1_scl	I/O	I2C1 clock
	i2c2_sda	I/O	I2C2 data
	i2c2_scl	I/O	I2C2 clock
	i2c3_sda	I/O	I2C3 data
	i2c3_scl	I/O	I2C3 clock
	i2c4_sda	I/O	I2C4 data
	i2c4_scl	I/O	I2C4 clock

Interface	Pin Name	Direction	Description
UART	uart0_sin	I	UART0 serial data input
	uart0_sout	O	UART0 serial data output
	uart0_cts_n	I	UART0 clear to send
	uart0_rts_n	O	UART0 request to send
	uart1_sin	I	UART1 serial data input
	uart1_sout	O	UART1 serial data output
	uart1_cts_n	O	UART1 clear to send
	uart1_rts_n	I	UART1 request to send
	uart2_sin	I	UART2 serial data input
	uart2_sout	O	UART2 serial data output
	uart3_sin	I	UART3 serial data input
	uart3_sout	O	UART3 serial data output
	uart3_cts_n	I	UART3 clear to send
	uart3_rts_n	O	UART3 request to send

Interface	Pin Name	Direction	Description
USB OTG 2.0	OTG_DM	N/A	USB OTG 2.0 Data signal DM
	OTG_RKELVIN	N/A	USB OTG 2.0 Transmitter Kelvin Connection to Resistor Tune Pin
	OTG_DP	N/A	USB OTG 2.0 Data signal DP
	OTG_VBUS	N/A	USB OTG 2.0 5-V power supply pin
	otg_drv_vbus	O	USB OTG 2.0 drive VBUS

Interface	Pin Name	Direction	Description
USB Host 2.0	HOST_DM	N/A	USB HOST 2.0 Data signal DM
	HOST_RKELVIN	N/A	USB HOST 2.0 Transmitter Kelvin Connection to Resistor Tune Pin
	HOST_DP	N/A	USB HOST 2.0 Data signal DP
	HOST_VBUS	N/A	USB HOST 2.0 5-V power supply pin

host_drv_vbus	O	USB HOST 2.0 drive VBUS
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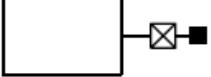
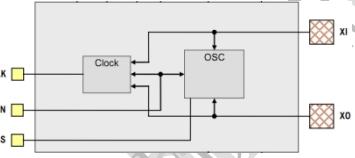
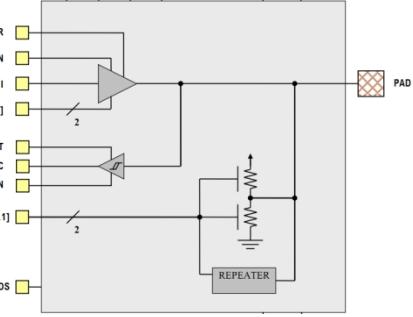
Interface	Pin Name	Direction	Description
SAR-ADC	SARADC_AIN[i] (i=0~2)	N/A	SAR-ADC input signal for 3 channel

Interface	Pin Name	Direction	Description
eFuse	EFUSE_VDDQ	N/A	eFuse program and sense power

1.3.4 RK3168 IO Type

The following list shows IO type except DDR IO and all of Power/Ground IO .

Table 1- 4 RK3168 IO Type List

Type	Diagram	Description	Pin Name
A		Analog IO Cell with IO voltage	EFUSE_VQPS
B		Dedicated Power supply to Internal Macro with IO voltage	SARADC_AIN[2:0]
C		Crystal Oscillator with high enable	XIN24M/XOUT24M
D		Tri-state output pad with input, which pullup/pulldown, slew rate and drive strength is configurable	Part of digital GPIO

1.4 Package information

RK3168 package is TFBGA453LD
(body: 19mm x 19mm ; ball size : 0.4mm ; ball pitch : 0.8mm)

1.4.1 Dimension

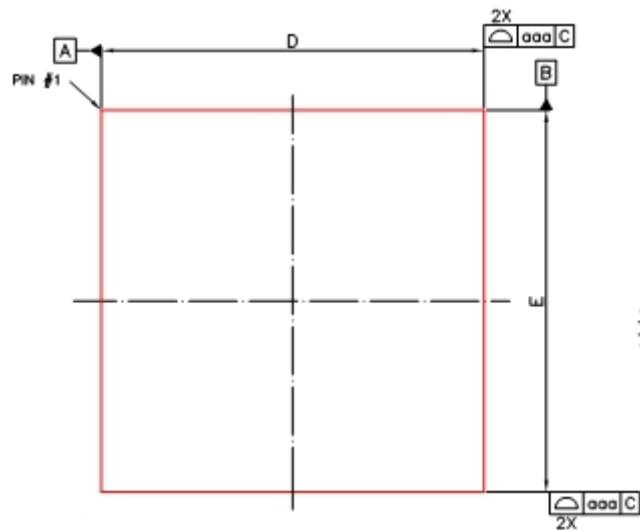


Fig. 1- 2RK3168 TFBGA453 Package Top View

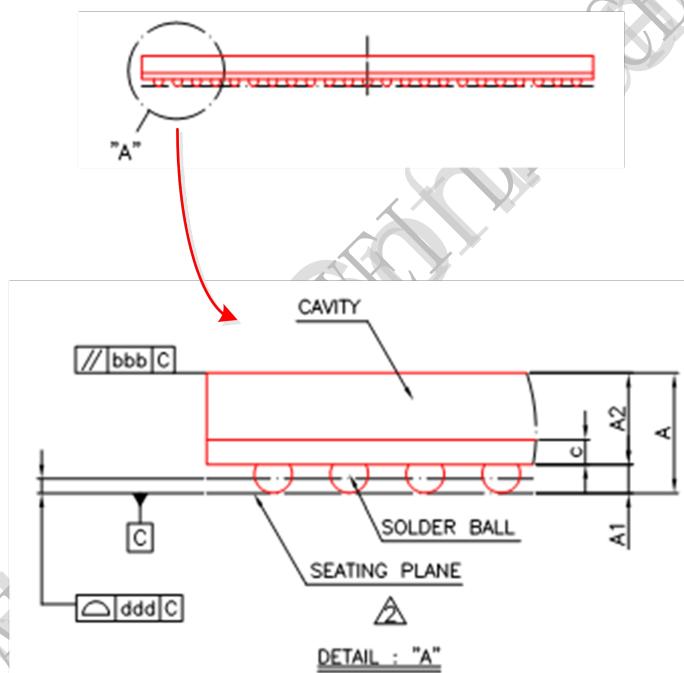


Fig. 1- 3RK3168 TFBGA453 Package Side View

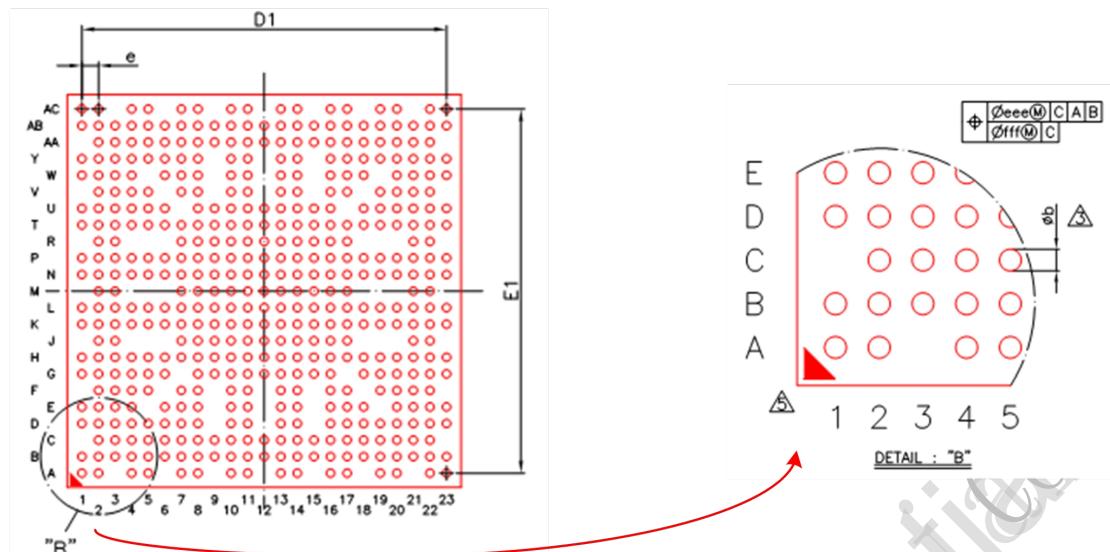


Fig. 1-4RK3168 TFBGA453 Package Bottom View

Symbol	Dimension in mm			Dimension in inch		
	MIN	NOM	MAX	MIN	NOM	MAX
A	---	---	1.40	---	---	0.055
A1	0.25	0.30	0.35	0.010	0.012	0.014
A2	0.91	0.96	1.01	0.036	0.038	0.040
b	0.35	0.40	0.45	0.014	0.016	0.018
c	0.22	0.26	0.30	0.009	0.010	0.012
D	18.90	19.00	19.10	0.744	0.748	0.752
E	18.90	19.00	19.10	0.744	0.748	0.752
D1	---	17.60	---	---	0.693	---
E1	---	17.60	---	---	0.693	---
e	---	0.80	---	---	0.031	---
aaa		0.15			0.006	
bbb		0.20			0.008	
ddd		0.15			0.006	
eee		0.15			0.006	
fff		0.08			0.003	
MD/ME	23/23			23/23		

Fig. 1-5RK3168 TFBGA453 Package Dimension

1.4.2 Ball Map

A	LCD0_HSY_N NC	MDM3	NP	MDQS_B3	MDQ31	NP	MDQS_B1	MCSN0	NP	MRASN	MA0	NP	MCK_N	MA5	NP	MA15	MDQ18	NP	MDQS_B2	MDQ19	NP	MDQS_B9	MDQ4	A
B	LCD0_VSY_N NC	MDQ24	MDQ25	MDQS_3	MDQ30	MDQ10	MDQS_1	MCIE1	MCIN1	MCASN	MBA2	MA2	MOK	MA6	MA11	MA14	MDQ17	MDQ21	MDQS_2	MDQ22	MDQ23	MDQS_0	MDQ5	B
C	NP	VSS	MDQ26	MDQ27	MDQ29	MDQ9	MDQ12	MDQ15	MCIE0	MCEN	MBA1	MA1	MA4	MA7	MA10	MA13	MDT1	MDQ16	MDQ20	MDM2	VSS	MDQ2	NP	C
D	LCD0_D0	LCD0_DCL_K	LCD0_DEN	VSS	MDQ28	MDQ8	VSS	MDQ14	NP	VSS	MBA0	NP	VSS	MA8	NP	VSS	MDT0	MA12	VSS	MDM0	MDQ1	MDQ3	MDQ6	D
E	LCD0_D1	LCD0_D2	LCD0_D3	LCD0_D4	NP	MDM1	MDQ11	MDQ13	NP	MRETN	MRESET	NP	MA3	MA9	NP	MT_ATO	MT.DTO1	MT.DTO0	NP	GPIO1_D5I_2C2_SCL	VSS	MDQ0	MDQ7	E
F	NP	LCD0_D9	LCD0_D8	LCD0_D7	LCD0_D6	NP	MVDD	MVDD	NP	MVDD	MVDD	NP	MVDD	MVDD	NP	MVDD	MVDD	NP	JTAG_SEL	GPIO3_B2	GPIO1_D4I_2C2_SDA	GPIO2_D7	NP	F
G	LCD0_D14	LCD0_D13	LCD0_D12	LCD0_D11	LCD0_D10	LCD0_D5	NP	CVDD_1V0	VSS	CVDD_1V0	MVDDAO	MVREFAO	MVREF	VSS	MPZQ	CVDD_1V0	NP	CVDD_1V0	GPIO1_D3I_2C1_SCL	GPIO1_D2I_2C1_SDA	GPIO1_D1I_2C0_SCL	GPIO1_D0I_2C0_SDA	GPIO3_D0/SDMMC1_PWR_MI_M	G
H	LCD0_D20	LCD0_D19	LCD0_D18	LCD0_D17	LCD0_D16	LCD0_D15	CVDD_1V0	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	CVDD_1V0	VCCD1	ADC_N2	ADC_N1	ADC_N0	GPIO3_D1/SDMMC1_BACENDMMI_MDCLK	GPIO3_D2/SDMMC1_IN	GPIO3_D0/SDMMC1_PWR_MI_M	H
J	NP	LCD0_D23	LCD0_D22	NP	NP	NP	LCD0_VCC_1	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	CVDD_1V0	NP	NP	NP	GPIO3_C6/SDMMC1_DETRMIL_RX_VP/RMIL_CS_ERR	GPIO3_C7/SDMMC1_ET/RMIL_RX_VP/RMIL_CS_R_VALD	NP	J	
K	LCD0_D21	GPIO2_A5/LCD1_D5/S MC_D5	GPIO2_A4/LCD1_D4/S MC_D4	GPIO2_A3/LCD1_D3/S MC_D3	GPIO2_A1/LCD1_D1/S MC_D1	GPIO2_A0/LCD1_D0/S MC_D0	LCD0_VCC_0	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VCCD0	ADCVDD_1V8	GPIO3_C3/SDMMC1_D2/RMIL_RX_D0	GPIO3_C4/SDMMC1_D3/RMIL_RX_D1	GPIO3_C5/SDMMC1_D2/RMIL_RX_D0	GPIO3_C1/SDMMC1_D3/RMIL_RX_D1	GPIO3_C2/SDMMC1_D1/RMIL_TX_D0	GPIO3_C0/SDMMC1_D1/RMIL_TX_D1	K	
L	GPIO2_B3/LCD1_D11/S MC_D11	GPIO2_B2/LCD1_D10/S MC_D10	GPIO2_B1/LCD1_D9/SM C_D9	GPIO2_A2/LCD1_D2/S MC_D2	GPIO2_A7/LCD1_D7/S MC_D7	GPIO2_A6/LCD1_D6/S MC_D6	LCD1_VCC	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	CVDD_1V0	CVDD_1V0	GPIO1_A1/UART0_RX	GPIO1_A0/UART0_TX	GPIO1_A2/UART0_CT_SN	GPIO1_A1/MDRMIL_TX_EN	GPIO1_A3/UART0_RT_SN	L	

LTD

M	NP	GPIO2_B4/L CD1_D12/S MC_A12	GPIO2_B0/L CD1_D12/S MC_D12	NP	NP	NP	CIF_VCC	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	CVDD_1V0	NP	NP	NP	GPIO3_B0/ SDMMC0_D ET	GPIO3_B1/ SDMMC0_W P	NP	
N	GPIO2_C1/L CD1_D17/S MC_A1	GPIO2_C0/L CD1_D17/S MC_A0	GPIO2_B7/L CD1_D16/S MC_D15	GPIO2_B5/L CD1_D13/S MC_D13	AVDD	AVDD	CVDD_1V0	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	FLASH_VC C	GPIO3_A0/ SDMMC0_R STN	GPIO1_B6/ SDPDI_FTX/S P1_CS1	GPIO3_A1/ SDMMC0_P WR	GPIO3_D7	GPIO3_D3 WM0	
P	GPIO2_C2/L CD1_D18/S MC_A2	GPIO2_C3/L CD1_D19/S MC_A3	GPIO2_C4/L CD1_D20/S MC_A4	GPIO2_B6/L CD1_D14/S MC_D14	AVDD	AVDD	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	CVDD_1V0	GPIO1_B1/ UART2_RX JTAG_TDO	GPIO1_B0/ UART2_RX JTAG_TDI	GPIO1_B5/ UART3_RT SN	GPIO3_D5/P VM2/JTAG _TCK	GPIO3_D6 VM3/JTA _TMS		
R	NP	GPIO2_C6/L CD1_D22/S MC_A6	GPIO2_C5/L CD1_D21/S MC_A5	NP	NP	NP	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	CVDD_1V0	NP	NP	NP	GPIO3_D5/P VM1/JTAG _TRSTN	NP		
T	GPIO2_D0/L CD1_DCLK/ SMC_CSND	GPIO2_D1/L CD1_DEN/S MC_WEN	GPIO2_D2/L CD1_HSYN C/SMC_OE N	GPIO2_C7/L CD1_D23/S MC_A7	AVDD	AVDD	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	CVDD_1V0	GPIO3_A3/ SDMMC0_C MD	GPIO3_A2/ SDMMC0_C LK0	GPIO0_D7/ SPI1_CS0	GPIO0_D6/ SPI1_CLK	GPIO1_B3/ UART3_TX/ GPS_SIG	GPIO1_B4 UART3_C SN/GPS_C K	
U	GPIO2_D3/L CD1_VSYN/ CSMC_AD VN	GPIO2_D4/ SMC_BLS _NO	GPIO2_D5/ SMC_BLS _N1	GPIO2_D6/ SMC_CSND	AVDD	AVDD	NP	AVDD	AVDD	APLL_AV S	C/GPLL_AV SS	DPLL_AV S	USBVDD_1V0	USBVDD_3V3	HSIC_VDD1 2	NP	AP1_VCC	FLASH_AL E	GPIO3_A7/ SDMMC0_D 3	GPIO1_B2/ UART3_RX/ GPS_MAG	GPIO3_A5/ SDMMC0_D 1	GPIO0_D4/ SPI1_RX	
V	NP	CIF_CLKI/T S_CLKO	VSS	CIF_D6/T5_ D4	AVDD	NP	AVDD	AVDD	NP	AVDD	APLL_1V0	NP	C/GPLL_1V 0	DPLL_1V0	NP	USBVDD_1V8	AP0_VCC	NP	GPIO0_C6/F LASH_D14	GPIO3_A4/ SDMMC0_D 0	GPIO0_C5/F LASH_D13	GPIO3_A6/ SDMMC0_D 2	NP
W	CIF_D8/T5_ D1	CIF_D4/T5_ D2	CIF_D5/T5_ D3	CIF_D9/T5_ D7	NP	GPIO0_A5	GPIO0_A3	GPIO0_B0	NP	AVDD_CO M	GPIO0_A6	NP	PVCC_3V3	PVDD_1V0	NP	GPIO1_C1/ 2S_SCLK	FLASH_RD	FLASH_CL E	NP	GPIO0_C1/F LASH_D9	GPIO0_C2/F LASH_D10	GPIO0_C0/F LASH_D8	GPIO0_C7 LASH_D1
Y	NC1	NC2	CIF_D7/T5_ D5	CIF_D8/T5_ D6	CIF_CLKO/ GPIO3_B3	GPIO0_A1	TEST	GPIO0_B3	NP	EFUSE	GPIO0_B6	NP	GPIO1_C0/ 25_CLK	GPIO1_C3/ 2S_LROK_T X	NP	GPIO1_A5/ UART1_TX/ SPI0_RXD	OTG_ID	FLASH_WP/ EMMC_PW R	FLASH_CS N0	GPIO0_D1/F LASH_D1	FLASH_D5/ EMMC_D5	FLASH_D3/ EMMC_D3	GPIO0_C3 LASH_D1
AA	NP	NC3	CIF_VSYNC/ TS_SYNC	CIF_D10/2C 3_SDA/GPI O3_B6	GPIO0_A2	GPIO0_A4	GPIO0_B1	VSS	DDRI0_PW ROFF	DDRI0_RET _EN	GPIO0_B7	GPIO1_A4/ UART1_RX/ SPI0_RXD	GPIO1_A6/ UART1_CT/ SN/SPD2_CL K	VSS	GPIO1_D7/I 2C4_SCL	VSS	OTG_VBUS	VSS	FLASH_WR N	GPIO0_D3/F LASH_CSN 3/EMMC_RS TN	FLASH_D2/ EMMC_D2	GPIO0_D2/F LASH_CSN 2/EMMC_C MD	NP
AB	NC4	CIF_HREF	CIF_D2/T5_ D0	CIF_D11/2C 3_SCL/GPI O3_B7	CLK32K_IN	GPIO0_B2	CPU_PVR FF	XIN24M	CORE_PVR OFF	GPIO0_B5	GPIO1_B7/ SPID_CS1	GPIO1_A7/ UART1_RT SN/SPD1_CS NO	GPIO1_O4/I 2S_SDI	OTG_DM	OTG_RKE VIN	HOST_DM	HSIC_STRO BE	HSIC_DATA	FLASH_RD N	GPIO0_D0/F LASH_DQ8/ EMMC_CLK 0	FLASH_D1/ EMMC_D1	FLASH_D7/ EMMC_D7	GPIO0_C4 LASH_D1
AC	CIF_D1/T5_ D9/GPIO3_ B5	CIF_D0/T5_ D8/GPIO3_ B4	NP	GPIO0_A0	NPOR	NP	GPIO0_A7	XOUT24M	NP	GPIO0_B4	GPIO1_D6/ 2C4_SDA	NP	GPIO_C5/I2 S_SDO	OTG_DP	NP	HOST_DP	HOST_RKE LVIN	NP	GPIO1_C2/I 2S_LROK_RX	FLASH_D0/ EMMC_D0	NP	FLASH_D4/ EMMC_D4	FLASH_D EMMC_D

Fig. 1- 6RK3168 Ball Mapping Diagram

1.4.3 Ball Pin Number Order

Table 1- 5RK3168Ball Pin Number Order Information

Ball #	Ball Pin Name	Ball #	Ball Pin Name
A1	LCD0_HSYNC	B1	LCD0_VSYNC
A2	MDM3	B2	MDQ24
A3	NP	B3	MDQ25
A4	MDQS_B3	B4	MDQS_3
A5	MDQ31	B5	MDQ30
A6	NP	B6	MDQ10
A7	MDQS_B1	B7	MDQS_1
A8	MCSN0	B8	MCKE1
A9	NP	B9	MCSN1
A10	MRASN	B10	MCASN
A11	MA0	B11	MBA2
A12	NP	B12	MA2
A13	MCK_N	B13	MCK
A14	MA5	B14	MA6
A15	NP	B15	MA11
A16	MA15	B16	MA14
A17	MDQ18	B17	MDQ17
A18	NP	B18	MDQ21
A19	MDQS_B2	B19	MDQS_2
A20	MDQ19	B20	MDQ22
A21	NP	B21	MDQ23
A22	MDQS_B0	B22	MDQS_0
A23	MDQ4	B23	MDQ5
C1	NP	D1	LCD0_D0
C2	VSS	D2	LCD0_DCLK
C3	MDQ26	D3	LCD0_DEN
C4	MDQ27	D4	VSS
C5	MDQ29	D5	MDQ28
C6	MDQ9	D6	MDQ8
C7	MDQ12	D7	VSS
C8	MDQ15	D8	MDQ14
C9	MCKE0	D9	NP
C10	MWEN	D10	VSS
C11	MBA1	D11	MBA0
C12	MA1	D12	NP
C13	MA4	D13	VSS
C14	MA7	D14	MA8
C15	MA10	D15	NP
C16	MA13	D16	VSS

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C17	MODT1	D17	MODT0
C18	MDQ16	D18	MA12
C19	MDQ20	D19	VSS
C20	MDM2	D20	MDM0
C21	VSS	D21	MDQ1
C22	MDQ2	D22	MDQ3
C23	NP	D23	MDQ6
E1	LCD0_D1	F1	NP
E2	LCD0_D2	F2	LCD0_D9
E3	LCD0_D9	F3	LCD0_D8
E4	LCD0_D7	F4	LCD0_D7
E5	NP	F5	LCD0_D6
E6	MDM1	F6	NP
E7	MDQ11	F7	MVDD
E8	MDQ13	F8	MVDD
E9	NP	F9	NP
E10	MRETN	F10	MVDD
E11	MRESET	F11	MVDD
E12	NP	F12	NP
E13	MA3	F13	MVDD
E14	MA9	F14	MVDD
E15	NP	F15	NP
E16	MT_ATO	F16	MVDD
E17	MT.DTO1	F17	MVDD
E18	MT.DTO0	F18	NP
E19	NP	F19	JTAG_SEL
E20	GPIO1_D5/I2C2_SCL	F20	GPIO3_B2
E21	VSS	F21	GPIO1_D4/I2C2_SDA
E22	MDQ0	F22	GPIO2_D7
E23	MDQ7	F23	NP
G1	LCD0_D14	H1	LCD0_D0
G2	LCD0_D13	H2	LCD0_D19
G3	LCD0_D12	H3	LCD0_D18
G4	LCD0_D11	H4	LCD0_D17
G5	LCD0_D10	H5	LCD0_D16
G6	LCD0_D5	H6	LCD0_D15
G7	NP	H7	CVDD_1V0
G8	CVDD_1V0	H8	VSS
G9	VSS	H9	VSS
G10	CVDD_1V0	H10	VSS
G11	MVDDAO	H11	VSS

G12	MVREFAO	H12	VSS
G13	MVREF	H13	VSS
G14	VSS	H14	VSS
G15	MPZQ	H15	VSS
G16	CVDD_1V0	H16	VSS
G17	NP	H17	CVDD_1V0
G18	CVDD_1V0	H18	VCCIO1
G19	GPIO1_D3/I2C1_SCL	H19	ADC_IN2
G20	GPIO1_D2/I2C1_SDA	H20	ADC_IN1
G21	GPIO1_D1/I2C0_SCL	H21	ADC_IN0
G22	GPIO1_D0/I2C0_SDA	H22	GPIO3_D1/SDMMC1_BACKEND/MII_MD CLK
G23	GPIO3_D0/SDMMC1_PWR/MII_MD	H23	GPIO3_D2/SDMMC1_INT
J1	NP	K1	LCD0_D21
J2	LCD0_D23	K2	GPIO2_A5/LCD1_D5/SMC_D5
J3	LCD0_D22	K3	GPIO2_A4/LCD1_D4/SMC_D4
J4	NP	K4	GPIO2_A3/LCD1_D3/SMC_D3
J5	NP	K5	GPIO2_A1/LCD1_D1/SMC_D1
J6	NP	K6	GPIO2_A0/LCD1_D0/SMC_D0
J7	LCD0_VCC1	K7	LCD0_VCC0
J8	VSS	K8	VSS
J9	VSS	K9	VSS
J10	VSS	K10	VSS
J11	VSS	K11	VSS
J12	VSS	K12	VSS
J13	VSS	K13	VSS
J14	VSS	K14	VSS
J15	VSS	K15	VSS
J16	VSS	K16	VSS
J17	CVDD_1V0	K17	VCCIO0
J18	NP	K18	ADCVDD_1V8
J19	NP	K19	GPIO3_C3/SDMMC1_D2/RMII_RX_D0
J20	NP	K20	GPIO3_C4/SDMMC1_D3/RMII_RX_D1
J21	GPIO3_C6/SDMMC1_DET/RMII_RX_ERR	K21	GPIO3_C5/SDMMC1_CLKO/RMII_CLKO
J22	GPIO3_C7/SDMMC1_WP/RMII_CSR_VALI D	K22	GPIO3_C1/SDMMC1_D0/RMII_TX_D1
J23	NP	K23	GPIO3_C2/SDMMC1_D1/RMII_TX_D0
L1	GPIO2_B3/LCD1_D11/SMC_D11	M1	NP
L2	GPIO2_B2/LCD1_D10/SMC_D10	M2	GPIO2_B4/LCD1_D12/SMC_D12
L3	GPIO2_B1/LCD1_D9/SMC_D9	M3	GPIO2_B0/LCD1_D8/SMC_D8
L4	GPIO2_A2/LCD1_D2/SMC_D2	M4	NP
L5	GPIO2_A7/LCD1_D7/SMC_D7	M5	NP

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L6	GPIO2_A6/LCD1_D6/SMC_D6	M6	NP
L7	LCD1_VCC	M7	CIF_VCC
L8	VSS	M8	VSS
L9	VSS	M9	VSS
L10	VSS	M10	VSS
L11	VSS	M11	VSS
L12	VSS	M12	VSS
L13	VSS	M13	VSS
L14	VSS	M14	VSS
L15	VSS	M15	VSS
L16	VSS	M16	VSS
L17	CVDD_1V0	M17	CVDD_1V0
L18	CVDD_1V0	M18	NP
L19	GPIO1_A1/UART0_TX	M19	NP
L20	GPIO1_A0/UART0_RX	M20	NP
L21	GPIO1_A2/UART0_CTSN	M21	GPIO3_B0/SDMMC0_DET
L22	GPIO3_C0/SDMMC1_CMD/RMII_TX_EN	M22	GPIO3_B1/SDMMC0_WP
L23	GPIO1_A3/UART0_RTSN	M23	NP
N1	GPIO2_C1/LCD1_D17/SMC_A1	P1	GPIO2_C2/LCD1_D18/SMC_A2
N2	GPIO2_C0/LCD1_D16/SMC_A0	P2	GPIO2_C3/LCD1_D19/SMC_A3
N3	GPIO2_B7/LCD1_D15/SMC_D15	P3	GPIO2_C4/LCD1_D20/SMC_A4
N4	GPIO2_B5/LCD1_D13/SMC_D13	P4	GPIO2_B6/LCD1_D14/SMC_D14
N5	AVDD	P5	AVDD
N6	AVDD	P6	AVDD
N7	CVDD_1V0	P7	VSS
N8	VSS	P8	VSS
N9	VSS	P9	VSS
N10	VSS	P10	VSS
N11	VSS	P11	VSS
N12	VSS	P12	VSS
N13	VSS	P13	VSS
N14	VSS	P14	VSS
N15	VSS	P15	VSS
N16	VSS	P16	VSS
N17	VSS	P17	VSS
N18	FLASH_VCC	P18	CVDD_1V0
N19	GPIO3_A0/SDMMC0_RSTN	P19	GPIO1_B1/UART2_TX/JTAG_TDO
N20	GPIO1_B6/SPDIF_TX/SPI1_CS1	P20	GPIO1_B0/UART2_RX/JTAG_TDI
N21	GPIO3_A1/SDMMC0_PWR	P21	GPIO1_B5/UART3_RTSN
N22	GPIO3_D7	P22	GPIO3_D5/PWM2/JTAG_TCK
N23	GPIO3_D3/PWM0	P23	GPIO3_D6/PWM3/JTAG_TMS

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R1	NP	T1	GPIO2_D0/LCD1_DCLK/SMC_CS0
R2	GPIO2_C6/LCD1_D22/SMC_A6	T2	GPIO2_D1/LCD1_DEN/SMC_WEN
R3	GPIO2_C5/LCD1_D21/SMC_A5	T3	GPIO2_D2/LCD1_HSYNC/SMC_OEN
R4	NP	T4	GPIO2_C7/LCD1_D23/SMC_A7
R5	NP	T5	AVDD
R6	NP	T6	AVDD
R7	VSS	T7	VSS
R8	VSS	T8	VSS
R9	VSS	T9	VSS
R10	VSS	T10	VSS
R11	VSS	T11	VSS
R12	VSS	T12	VSS
R13	VSS	T13	VSS
R14	VSS	T14	VSS
R15	VSS	T15	VSS
R16	VSS	T16	VSS
R17	CVDD_1V0	T17	CVDD_1V0
R18	NP	T18	GPIO3_A3/SDMMC0_CMD
R19	NP	T19	GPIO3_A2/SDMMC0_CLKO
R20	NP	T20	GPIO0_D7/SPI1_CS0
R21	GPIO0_D5/SPI1_TX	T21	GPIO0_D6/SPI1_CLK
R22	GPIO3_D4/PWM1/JTAG_TRSTN	T22	GPIO1_B3/UART3_RX/GPS_SIG
R23	NP	T23	GPIO1_B4/UART3_CTSN/GPS_CLK
U1	GPIO2_D3/LCD1_VSYNC/SMC_ADVN	V1	NP
U2	GPIO2_D4/SMC_BLS_N0	V2	CIF_CLKI/TS_CLKO
U3	GPIO2_D5/SMC_BLS_N1	V3	VSS
U4	GPIO2_D6/SMC_CS1	V4	CIF_D6/TS_D4
U5	AVDD	V5	AVDD
U6	AVDD	V6	NP
U7	NP	V7	AVDD
U8	AVDD	V8	AVDD
U9	AVDD	V9	NP
U10	AVDD	V10	AVDD
U11	APLL_AVSS	V11	APLL_1V0
U12	C/GPLL_AVSS	V12	NP
U13	DPLL_AVSS	V13	C/GPLL_1V0
U14	USBDVDD_1V0	V14	DPLL_1V0
U15	USBVDD_3V3	V15	NP
U16	HSIC_VDD12	V16	USBVDD_1V8
U17	NP	V17	AP0_VCC
U18	AP1_VCC	V18	NP

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U19	FLASH_ALE	V19	GPIO0_C6/FLASH_D14
U20	GPIO3_A7/SDMMC0_D3	V20	GPIO3_A4/SDMMC0_D0
U21	GPIO1_B2/UART3_RX/GPS_MAG	V21	GPIO0_C5/FLASH_D13
U22	GPIO3_A5/SDMMC0_D1	V22	GPIO3_A6/SDMMC0_D2
U23	GPIO0_D4/SPI1_RX	V23	NP
W1	CIF_D3/TS_D1	Y1	NC1
W2	CIF_D4/TS_D2	Y2	NC2
W3	CIF_D5/TS_D3	Y3	CIF_D7/TS_D5
W4	CIF_D9/TS_D7	Y4	CIF_D8/TS_D6
W5	NP	Y5	CIF_CLKO(GPIO3_B3)
W6	GPIO0_A5	Y6	GPIO0_A1
W7	GPIO0_A3	Y7	TEST
W8	GPIO0_B0	Y8	GPIO0_B3
W9	NP	Y9	NP
W10	AVDD_COM	Y10	EFUSE
W11	GPIO0_A6	Y11	GPIO0_B6
W12	NP	Y12	NP
W13	PVCC_3V3	Y13	GPIO1_C0/I2S_CLK
W14	PVDD_1V0	Y14	GPIO1_C3/I2S_LRCK_TX
W15	NP	Y15	NP
W16	GPIO1_C1/I2S_SCLK	Y16	GPIO1_A5/UART1_TX/SPI0_TXD
W17	FLASH_RDY	Y17	OTG_ID
W18	FLASH_CLE	Y18	FLASH_WP/EMMC_PWR
W19	NP	Y19	FLASH_CSNO
W20	GPIO0_C1/FLASH_D9	Y20	GPIO0_D1/FLASH_CSN1
W21	GPIO0_C2/FLASH_D10	Y21	FLASH_D5/EMMC_D5
W22	GPIO0_C0/FLASH_D8	Y22	FLASH_D3/EMMC_D3
W23	GPIO0_C7/FLASH_D15	Y23	GPIO0_C3/FLASH_D11
AA1	NP	AB1	NC1
AA2	NC3	AB2	CIF_HREF
AA3	CIF_VSYNC/TS_SYNC	AB3	CIF_D2/TS_D0
AA4	CIF_D10/I2C3_SDA(GPIO3_B6)	AB4	CIF_D11/I2C3_SCL(GPIO3_B7)
AA5	GPIO0_A2	AB5	CLK32K_IN
AA6	GPIO0_A4	AB6	GPIO0_B2
AA7	GPIO0_B1	AB7	CPU_PWROFF
AA8	VSS	AB8	XIN24M
AA9	DDRIO_PWROFF	AB9	CORE_PWROFF
AA10	DDRIO_RET_EN	AB10	GPIO0_B5
AA11	GPIO0_B7	AB11	GPIO1_B7/SPI0_CSN1
AA12	GPIO1_A4/UART1_RX/SPI0_RXD	AB12	GPIO1_A7/UART1_RTSN/SPI0_CSN0
AA13	GPIO1_A6/UART1_CTSN/SPI0_CLK	AB13	GPIO1_C4/I2S_SD1

AA14	VSS	AB14	OTG_DM
AA15	GPIO1_D7/I2C4_SCL	AB15	OTG_RKELVIN
AA16	VSS	AB16	HOST_DM
AA17	OTG_VBUS	AB17	HSIC_STROBE
AA18	VSS	AB18	HSIC_DATA
AA19	FLASH_WRN	AB19	FLASH_RDN
AA20	GPIO0_D3/FLASH_CSN3/EMMC_RSTN	AB20	GPIO0_D0/FALSH_DQS/EMMC_CLKO
AA21	FLASH_D2/EMMC_D2	AB21	FLASH_D1/EMMC_D1
AA22	GPIO0_D2/FLASH_CSN2/EMMC_CMD	AB22	FLASH_D7/EMMC_D7
AA23	NP	AB23	GPIO0_C4/FLASH_D12
AC1	CIF_D1/TS_D9/GPIO3_B5	AC13	GPIO_C5/I2S_SDO
AC2	CIF_D0/TS_D8/GPIO3_B4	AC14	OTG_DP
AC3	NP	AC15	NP
AC4	GPIO0_A0	AC16	HOST_DP
AC5	NPOR	AC17	HOST_RKELVIN
AC6	NP	AC18	NP
AC7	GPIO0_A7	AC19	GPIO1_C2/I2S_LRCK_RX
AC8	XOUT24M	AC20	FLASH_D0/EMMC_D0
AC9	NP	AC21	NP
AC10	GPIO0_B4	AC22	FLASH_D4/EMMC_D4
AC11	GPIO1_D6/I2C4_SDA	AC23	FLASH_D6/EMMC_D6
AC12	NP		

1.5 Electrical Specification

1.5.1 Absolute Maximum Ratings

Table 1-6 RK3168 absolute maximum ratings

Parameters	Related Power Group	Max	Unit
DC supply voltage for Internal digital logic	AVDD, CVDD, PVDD, USBDVDD	1.1	V
DC supply voltage for Digital GPIO (except for SAR-ADC, PLL, USB, DDR IO)	LCD0_VCC0,LCD0_VCC1, LCD1_VCC, CIF_VCC PVCC_3V3, AP0_VCC,AP1_VCC, FLASH_VCC, VCCIO0,VCCIO1	3.6	V
DC supply voltage for DDR IO	MVDD	1.95	V
DC supply voltage for Analog part of SAR-ADC	ADCVDD_1V8	1.98	V

DC supply voltage for Analog part of PLL	APLL_1V0 CGPLL_1V0 DPLL_1V0	1.1	V
DC supply voltage for Analog part of USB OTG/Host2.0	USBVDD_1V8 USBVDD_3V3	1.98 3.63	V
Analog Input voltage for SAR-ADC	ADCVDD_1V8	1.98	V
Analog Input voltage for DP/DM/VBUS of USB OTG/Host2.0		5	V
Digital input voltage for input buffer of GPIO		3.6	V
Digital output voltage for output buffer of GPIO		3.6	V
Storage Temperature		125	°C

Absolute maximum ratings specify the values beyond which the device may be damaged permanently. Long-term exposure to absolute maximum ratings conditions may affect device reliability.

1.5.2 Recommended Operating Conditions

Table 1-7 RK3168 recommended operating conditions

Parameters	Symbol	Min	Typ	Max	Units
Internal digital logic Power (except USB OTG)	AVDD, CVDD, PVDD	0.9	1.0	1.1	V
Digital GPIO Power(3.3V)	VCCIO0,VCCIO1,	3	3.3	3.6	V
Digital GPIO Power(3.3V/1.8V)	LCD0_VCC0, LCD0_VCC1, LCD1_VCC, CIF_VCC, PVCC, FLASH_VCC, AP0_VCC, AP1_VCC	3 1.62	3.3 1.8	3.6 1.98	V
DDR IO (DDR3 mode) Power	MVDD	1.425	1.5	1.575	V
DDR IO (LPDDR2 mode) Power	MVDD	1.14	1.2	1.3	V
DDR reference supply (VREF) Input	VREF	0.49*MVDD	0.5*MVDD	0.51*MVDD	V
DDR External termination voltage		VREF- 40mV	VREF	VREF+ 40mV	V
PLL Analog Power	APLL_1V0 CGPLL_1V0 DPLL_1V0	0.9	1.0	1.1	V
SAR-ADC Analog Power	ADCVDD_1V8	1.62	1.8	1.98	V
USB OTG/Host2.0 Digital Power	USBDVDD_1V0	0.9	1.0	1.1	V
USB OTG/Host2.0 Analog Power(1.8V)	USBVDD_1V8	1.62	1.8	1.98	V
USB OTG/Host2.0 Analog Power(3.3V)	USBVDD_3V3	3.069	3.3	3.63	V
USB OTG/Host2.0 external resistor	REXT	NA	200	NA	Ohm
PLL input clock frequency		N/A	24	N/A	MHz

Operating Temperature		-40	25	125	°C
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1.5.3 DC Characteristics

Table 1-8 RK3168 DC Characteristics

Parameters		Symbol	Min	Typ	Max	Units
Digital GPIO @3.3V	Input Low Voltage	Vil	-0.3	0	3.3x0.3	V
	Input High Voltage	Vih	3.3x0.7	3.3	3.3+0.3	V
	Output Low Voltage	Vol	-0.3	NA	NA	V
	Output High Voltage	Voh	NA	NA	3.6	V
	Threshold Point	Vtr+	1.53	1.46	1.43	V
		Vtr-	1.19	1.12	1.05	V
	Pullup Resistor	Rpu	33.7	58	101.5	Kohm
	Pulldown Resistor	Rpd	34.2	60.1	109.3	Kohm
Digital GPIO @1.8V	Input Low Voltage	Vil	-0.3	0	1.8x0.3	V
	Input High Voltage	Vih	1.8x0.7	1.8	1.8 + 0.3	V
	Output Low Voltage	Vol	-0.3	NA	NA	V
	Output High Voltage	Voh	NA	NA	1.8+0.3	V
	Threshold Point	Vtr+	1.23	1.12	1.03	V
		Vtr-	0.91	0.82	0.73	V
	Pullup Resistor	Rpu	35	62.9	120	Kohm
	Pulldown Resistor	Rpd	35.1	61	113.9	Kohm
DDR IO @DDR3 mode	Input High Voltage	Vih_ddr	VREF + 0.09	NA	MVDD	V
	Input Low Voltage	Vil_ddr	-0.3	0	VREF - 0.09	V
	Output High Voltage	Voh_ddr	0.8xMVDD	NA	N/A	V
	Output Low Voltage	Vol_ddr	N/A	NA	0.2*MVDD	V
	Input termination resistance(ODT) to VDDIO_DDRI/2 (i=0~6)	Rtt	100	120	140	
			54	60	66	Ohm
			36	40	44	
DDR IO @LPDDR2 mode	Input High Voltage	Vih_ddr	VREF + 0.13	NA	MVDD	V
	Input Low Voltage	Vil_ddr	-0.3	NA	VREF - 0.13	V
	Output High Voltage	Voh_ddr	0.9*VREF	NA	NA	V
	Output Low Voltage	Vol_ddr	NA	NA	0.1*VREF	V

1.5.4 Recommended Operating Frequency

Table 1-9 Recommended operating frequency for PD_ALIVE domain

Parameter	Condition	Symbol	MIN	TYP	MAX	Unit
XIN Oscillator	1.0V , 25 °C	IO_XIN24M	24	24	24	MHz
	1.1V , -40 °C		24	24	24	
	0.9V , 125 °C		24	24	24	
DDR PLL	1.0V , 25 °C	ddr_pll_clk	N/A	N/A	1790	MHz
	1.1V , -40 °C		N/A	N/A	2000	

	0.9V , 125 °C		N/A	N/A	1280	
ARM PLL	1.0V , 25 °C	arm_pll_clk	N/A	N/A	1500	MHz
	1.1V , -40 °C		N/A	N/A	2000	
	0.9V , 125 °C		N/A	N/A	1100	
CODEC PLL	1.0V , 25 °C	cocec_pll_clk	N/A	N/A	1305	MHz
	1.1V , -40 °C		N/A	N/A	1850	
	0.9V , 125 °C		N/A	N/A	965	
GENERAL PLL	1.0V , 25 °C	general_pll_c 1k	N/A	N/A	1305	MHz
	1.1V , -40 °C		N/A	N/A	1850	
	0.9V , 125 °C		N/A	N/A	965	
UART1CLK	1.0V , 25 °C	clk_uart1	N/A	N/A	225	MHz
	1.1V , -40 °C		N/A	N/A	260	
	0.9V , 125 °C		N/A	N/A	188	
TIMER3 CLK	1.0V , 25 °C	clk_timer3	N/A	N/A	253	MHz
	1.1V , -40 °C		N/A	N/A	395	
	0.9V , 125 °C		N/A	N/A	176	

Table 1- 10 Recommended operating frequency for A9 core

Parameter	Condition	Symbol	MIN	TYP	MAX	Unit
Cortex-A9	1.0V , 25 °C	clk_core_pre	N/A	N/A	1410	MHz
	1.1V , -40 °C		N/A	N/A	1800	
	0.9V , 125 °C		N/A	N/A	930	
	1.0V , 25 °C	clk_core_peri	N/A	N/A	384	MHz
	1.1V , -40 °C		N/A	N/A	530	
	0.9V , 125 °C		N/A	N/A	273	

Table 1- 11 Recommended operating frequency for PD_CPU domain

Parameter	Condition	Symbol	MIN	TYP	MAX	Unit
CPU AXI interconnect	1.0V , 25 °C	aclk_cpu	N/A	N/A	521	MHz
	1.1V , -40 °C		N/A	N/A	820	
	0.9V , 125 °C		N/A	N/A	400	
	1.0V , 25 °C	hclk_cpu	N/A	N/A	323	MHz
	1.1V , -40 °C		N/A	N/A	460	
	0.9V , 125 °C		N/A	N/A	200	
	1.0V , 25 °C	pclk_cpu	N/A	N/A	155	MHz
	1.1V , -40 °C		N/A	N/A	200	
	0.9V , 125 °C		N/A	N/A	100	
DMC	1.0V , 25 °C	clk_ddr	N/A	N/A	557	MHz
	1.1V , -40 °C		N/A	N/A	750	
	0.9V , 125 °C		N/A	N/A	387	
Embedded SRAM	1.0V , 25 °C	aclk_intmem	N/A	N/A	660	MHz
	1.1V , -40 °C		N/A	N/A	960	
	0.9V , 125 °C		N/A	N/A	400	

SPDIF	1.0V , 25 °C	clk_spdif	N/A	N/A	358	MHz
	1.1V , -40 °C		N/A	N/A	560	
	0.9V , 125 °C		N/A	N/A	250	
Timer0/1	1.0V , 25 °C	clk_timer0/ clk_timer1	N/A	N/A	257	MHz
	1.1V , -40 °C		N/A	N/A	400	
	0.9V , 125 °C		N/A	N/A	180	
UART0	1.0V , 25 °C	clk_uart0	N/A	N/A	225	MHz
	1.1V , -40 °C		N/A	N/A	260	
	0.9V , 125 °C		N/A	N/A	180	
I2S1	1.0V , 25 °C	clk_i2s0	N/A	N/A	52	MHz
	1.1V , -40 °C		N/A	N/A	53	
	0.9V , 125 °C		N/A	N/A	49	

Table 1-12 Recommended operating frequency for PD_PERI domain

Parameter	Condition	Symbol	MIN	TYP	MAX	Unit
PERI AXI interconnect	1.0V , 25 °C	aclk_periph	N/A	N/A	830	MHz
	1.1V , -40 °C		N/A	N/A	1587	
	0.9V , 125 °C		N/A	N/A	494	
	1.0V , 25 °C	hclk_periph	N/A	N/A	326	MHz
	1.1V , -40 °C		N/A	N/A	590	
	0.9V , 125 °C		N/A	N/A	200	
	1.0V , 25 °C	pclk_periph	N/A	N/A	158	MHz
	1.1V , -40 °C		N/A	N/A	230	
	0.9V , 125 °C		N/A	N/A	110	
SMC	1.0V , 25 °C	clk_smc	N/A	N/A	689	MHz
	1.1V , -40 °C		N/A	N/A	850	
	0.9V , 125 °C		N/A	N/A	440	
NANDC	1.0V , 25 °C	hclk_nandc	N/A	N/A	307	MHz
	1.1V , -40 °C		N/A	N/A	400	
	0.9V , 125 °C		N/A	N/A	200	
USB Host	1.0V , 25 °C	clk_otgphy1	N/A	N/A	480	MHz
	1.1V , -40 °C		N/A	N/A	480	
	0.9V , 125 °C		N/A	N/A	480	
USB OTG	1.0V , 25 °C	clk_otgphy0	N/A	N/A	480	MHz
	1.1V , -40 °C		N/A	N/A	480	
	0.9V , 125 °C		N/A	N/A	480	
UART2/3	1.0V , 25 °C	clk_uart2/ clk_uart3	N/A	N/A	157	MHz
	1.1V , -40 °C		N/A	N/A	190	
	0.9V , 125 °C		N/A	N/A	120	
SDMMC/SDIO	1.0V , 25 °C	clk_sdmmc0/ clk_sdio	N/A	N/A	100	MHz
	1.1V , -40 °C		N/A	N/A	105	
	0.9V , 125 °C		N/A	N/A	90	
EMMC	1.0V , 25 °C	clk_emmc	N/A	N/A	104	MHz

	1. 1V , -40 °C		N/A	N/A	108	
	0. 9V , 125 °C		N/A	N/A	95	
MAC	1. 0V , 25 °C	clk_mac_ref	N/A	N/A	51	MHz
	1. 1V , -40 °C		N/A	N/A	51	
	0. 9V , 125 °C		N/A	N/A	49	
SPI0/1	1. 0V , 25 °C	clk_spi0/ clk_spi1	N/A	N/A	135	MHz
	1. 1V , -40 °C		N/A	N/A	159	
	0. 9V , 125 °C		N/A	N/A	100	
SAR-ADC	1. 0V , 25 °C	clk_saradc	N/A	N/A	56	MHz
	1. 1V , -40 °C		N/A	N/A	66	
	0. 9V , 125 °C		N/A	N/A	49	
GPS	1. 0V , 25 °C	gps_rfclk	N/A	N/A	77	MHz
	1. 1V , -40 °C		N/A	N/A	80	
	0. 9V , 125 °C		N/A	N/A	70	

Table 1- 13 Recommended operating frequency for PD_VIO domain

Parameter	Condition	Symbol	MIN	TYP	MAX	Unit
Display AXI interconnection	1. 0V , 25 °C	aclk_lcdc0	N/A	N/A	647	MHz
	1. 1V , -40 °C		N/A	N/A	898	
	0. 9V , 125 °C		N/A	N/A	464	
	1. 0V , 25 °C	aclk_lcdc1	N/A	N/A	646	MHz
	1. 1V , -40 °C		N/A	N/A	900	
	0. 9V , 125 °C		N/A	N/A	468	
LCD0/1	1. 0V , 25 °C	vio_hclk	N/A	N/A	304	MHz
	1. 1V , -40 °C		N/A	N/A	536	
	0. 9V , 125 °C		N/A	N/A	254	
	1. 0V , 25 °C	dclk_lcdc0/ dclk_lcdc1	N/A	N/A	255	MHz
	1. 1V , -40 °C		N/A	N/A	454	
	0. 9V , 125 °C		N/A	N/A	150	
CIF0/1	1. 0V , 25 °C	pclkin_cif0/ pclkin_cif1	N/A	N/A	100	MHz
	1. 1V , -40 °C		N/A	N/A	100	
	0. 9V , 125 °C		N/A	N/A	100	

Table 1- 14 Recommended operating frequency PD_GPU domain

Parameter	Condition	Symbol	MIN	TYP	MAX	Unit
GPU	1. 0V , 25 °C	aclk_gpu	N/A	N/A	600	MHz
	1. 1V , -40 °C		N/A	N/A	800	
	0. 9V , 125 °C		N/A	N/A	400	

Table 1- 15 Recommended operating frequency for PD_VIDEO domain

Parameter	Condition	Symbol	MIN	TYP	MAX	Unit
VIDEO	1. 0V , 25 °C	aclk_vepu	N/A	N/A	638	MHz
	1. 1V , -40 °C		N/A	N/A	900	

0.9V , 125 °C		N/A	N/A	400	
1.0V , 25 °C	hclk_vepu	N/A	N/A	129	MHz
1.1V , -40 °C		N/A	N/A	217	
0.9V , 125 °C		N/A	N/A	100	
1.0V , 25 °C	aclk_vdpu	N/A	N/A	576	MHz
1.1V , -40 °C		N/A	N/A	810	
0.9V , 125 °C		N/A	N/A	370	
1.0V , 25 °C	hclk_vdpu	N/A	N/A	141	MHz
1.1V , -40 °C		N/A	N/A	200	
0.9V , 125 °C		N/A	N/A	92.5	

1.5.5 Electrical Characteristics for General IO

Table 1- 16 RK3168 Electrical Characteristics for Digital General IO

Parameters		Symbol	Test condition	Min	Typ	Max	Units
Digital GPIO @3.3V	Input leakage current	I _l	V _{in} = 3.3V or 0V	NA	NA	10	uA
	Tri-state output leakage current	I _{oZ}	V _{out} = 3.3V or 0V	NA	NA	10	uA
	High level input current	I _{lh}	V _{in} = 3.3V, pulldown disabled	NA	NA	10	uA
			V _{in} = 3.3V, pulldown enabled	NA	NA	106.4	uA
	Low level input current	I _{ll}	V _{in} = 0V, pullup disabled	NA	NA	10	uA
			V _{in} = 0V, pullup enabled	NA	NA	107.8	uA
Digital GPIO @1.8V	Input leakage current	I _l	V _{in} = 1.8V or 0V	NA	NA	10	uA
	Tri-state output leakage current	I _{oZ}	V _{out} = 1.8V or 0V	NA	NA	10	uA
	High level input current	I _{lh}	V _{in} = 1.8V, pulldown disabled	NA	NA	10	uA
			V _{in} = 1.8V, pulldown enabled	NA	NA	61.3	uA
	Low level input current	I _{ll}	V _{in} = 0V, pullup disabled	NA	NA	10	uA
			V _{in} = 0V, pullup enabled	NA	NA	61.4	uA

1.5.6 Electrical Characteristics for PLL

Table 1- 17 RK3168 Electrical Characteristics for PLL

Parameters		Symbol	Test condition	Min	Typ	Max	Units
PLL	Input clock frequency	F _{in}	F _{in} = F _{ref} * NR① @1.0V	0.032	NA	2200	MHz
	Comparison frequency	F _{ref}	F _{ref} = F _{in} /NR@1.0V	0.032	N/A	50	MHz
	VCO operating range	F _{vco}	F _{vco} = F _{ref} * NF① @1.0V	1100	N/A	2200	MHz

Output clock frequency	Fout	Fout = Fvco/NO① @1.0V	30	N/A	2200	MHz
Lock time	Tlt		N/A	350	500	Cycles of divided reference clock
Power consumption (normal mode)	N/A		N/A	4	N/A	mW
Power consumption (standby mode)	N/A		N/A	100	N/A	uW
Power consumption (power-down mode)	N/A	No clock input to PLL power down signal high, 80C temperature	N/A	10	N/A	uW

Notes : ① NR is the input divider value;
 NF is the feedback divider value;
 NO is the output divider value

1.5.7 Electrical Characteristics for SAR-ADC

Table 1-18 RK3168 Electrical Characteristics for SAR-ADC

Parameters	Symbol	Test condition	Min	Typ	Max	Units
ADC resolution			N/A	10	N/A	bits
Conversion speed	Fs	The duty cycle should be between 40%~60%	NA	N/A	1	MSPS
Differential Non Linearity	DNL		N/A	±1	N/A	LSB
Integral Non Linearity	INL		N/A	±2	N/A	LSB
Gain Error	Egain		-8	N/A	8	LSB
Offset Error	Eoffset		-8	N/A	8	mV
Analog Supply Current(VDDA_SARADC)			N/A	200	N/A	uA
Digital Supply Current			N/A	50	N/A	uA
Power Down Current from AVDD			NA	0.5	NA	uA
Power Down Current from DVDD			N/A	1	N/A	uA
Power up time			N/A	7	N/A	1/Fs

1.5.8 Electrical Characteristics for USB OTG/Host2.0 Interface

Table 1-19 RK3168 Electrical Characteristics for USB OTG/Host2.0 Interface

Parameters	Symbol	Test condition	Min	Typ	Max	Units
HS transmit, maximum transition density (all 0's data in DP/DM)	Current From OTG_DVDD	55°C , USBDVDD_1V0 = 1.0V USBVDD_1V8=1.0V USBVDD_3V3=3.3V, 15-cm USB cable	N/A	6.151	N/A	mA
	Current From OTG_VDD33		N/A	4.97	N/A	mA
	Current From OTG_VDD18		N/A	18.5	N/A	mA
HS transmit, minimum transition density	Current From OTG_DVDD		N/A	5.521	N/A	mA
	Current From OTG_VDD33		N/A	3.63	N/A	mA

(all 1's data in DP/DM)	Current From OTG_VDD18		attached to DP/DM	N/A	15.5	N/A	mA
HS idle mode	Current From OTG_DVDD			N/A	5.841	N/A	mA
	Current From OTG_VDD33			N/A	3.19	N/A	mA
	Current From OTG_VDD18			N/A	6.58	N/A	mA
FS transmit, maximum transition density (all 0's data in DP/DM)	Current From OTG_DVDD			N/A	4.251	N/A	mA
	Current From OTG_VDD33			N/A	11.81	N/A	mA
	Current From OTG_VDD18			N/A	6.56	N/A	mA
LS transmit, maximum transition density (all 0's data in DP/DM)	Current From OTG_DVDD			N/A	5.171	N/A	mA
	Current From OTG_VDD33			N/A	12.81	N/A	mA
	Current From OTG_VDD18			N/A	6.61	N/A	mA
Suspend mode	Current From OTG_DVDD			N/A	53.4	N/A	uA
	Current From OTG_VDD33			N/A	1.1	N/A	uA
	Current From OTG_VDD18			N/A	6.6	N/A	uA
Sleep mode	Current From OTG_DVDD			N/A	0.113	N/A	mA
	Current From OTG_VDD33			N/A	0.1	N/A	uA
	Current From OTG_VDD18			N/A	0.004	N/A	mA

1.5.9 Electrical Characteristics for DDR IO

Table 1- 20 RK3168 Electrical Characteristics for DDR IO

Parameters		Symbol	Test condition	Min	Typ	Max	Units
DDR IO @DDR3 mode	VDDIO_DDR standby current, ODT OFF		@ 1.5V , 125°C	NA	0.01	2.11	uA
	Input leakage current, SSTL mode, unterminated		@ 1.5V , 125°C	NA	0	0.53	uA
DDR IO @LPDDR2 mode		Input leakage current	@ 1.2V , 125°C	NA	0	0.49	nA
		VDD(1.2V) quiescent current	@ 1.2V , 125°C	NA	0	1.89	uA

1.5.10 Electrical Characteristics for eFuse

Table 1- 21 RK3168 Electrical Characteristics for eFuse

	Parameters	Symbol	Test condition	Min	Typ	Max	Units
Active mode	VDD current in Read mode	Iread_vdd	nomal read	NA	NA	8	mA
	VDD current in PGM mode	Ipqm_vdd	STROBE high	NA	NA	0.2	mA
	VQPS current in PGM mode	Ipqm_vqps	STROBE high	NA	NA	14	mA
standby mode	VDD current in standby mode	Istandby_vdd	Standby	NA	NA	60	uA

1.6 Hardware Guideline

1.6.1 Reference design for RK3168 oscillator PCB connection

RK3168 only use one oscillator, and its typical clock frequency is 24MHz. The

oscillator will provide input clock to four on-chip PLLs.

- External reference circuit for oscillators with 24MHz input

In the following diagram , the value for Rf,Rd,C1,C2 must be adjusted a little to improve performance of oscillator based on real crystal model . Especially C1 and C2 value is advised to meet formula $(C1 * C2)/(C1+C2) = \sim 8\text{pF}$

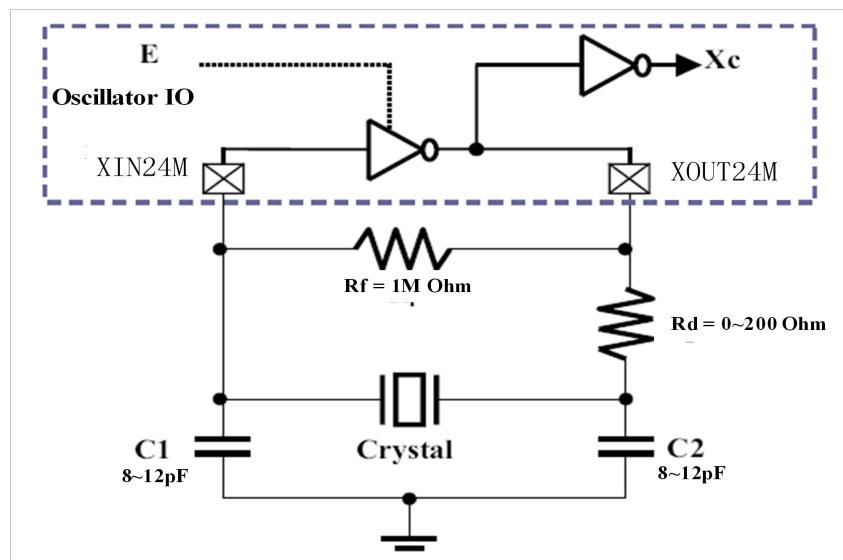


Fig. 1- 7 External Reference Circuit for 24MHzOscillators

1.6.2 Reference design for PLL PCB connection

The following reference design is suitable for PLL in RK3168.

The PLL's two analog supplies should be filtered with two series ferritebeads and two shunt 0.1uF and 0.01uF capacitors. The ferrite on VSS is preferred but optional. Adding the ferrite on VSS converts supply noise to substrate noise as seen by the PLL. The PLLs are designed to be relatively insensitive to supply and substrate noise, so the presence of this ferrite is a second order issue.

The VDD/VSS is mapped to VDD_APLL/VSS_APLL, VDD_DPLL/VSS_DPLL and VDD_CGPLL/VSS_CGPLL.

The AVDD/AVSS is mapped to AVDD_APLL/AVSS_APLL, AVDD_DPLL/AVSS_DPLL and AVDD_CGPLL/AVSS_CGPLL.

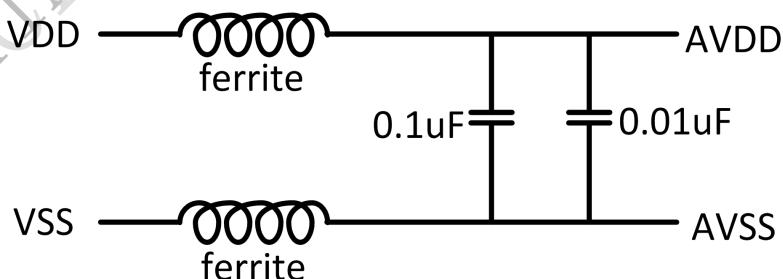


Fig. 1- 8 External reference circuit for PLL

The ferrite beads should be similar one of the following from Murata:

Table 1- 22 Ferrite Bead Selection

Part number	R@DC	Z@10MHz	Z@100MHz	size
BLM18EG601SN1	0.35	200	600	0603

BLM18PG471SN1	0.2	130	470	0603
BLM18KG601SN1	0.15	160	600	0603
BLM18AG601SN1	0.38	180	600	0603
BLM18AG102SN1	0.5	280	1000	0603
BLM18TG601TN1	0.45	190	600	0603
BLM15AG601SN1	0.6	200	600	0402
BLM15AX601SN1	0.34	190	600	0402
BLM15AX102SN1	0.49	250	1000	0402
BLM03AX601SN1	0.85	120	600	0201

Similar ferrite beads are also available from Panasonic. The key characteristics to select are:

- DC resistance less than 0.40 ohms
- impedance at 10MHz equal to or greater 180 ohms
- impedance at 100MHz equal to or greater than 600 ohms

The capacitors should be mounted as close to the package balls as possible.

1.6.3 Reference design for USB OTG/Host2.0 connection

In RK3168 there are USB OTG and USB Host2.0 interface, in fact, same interface is for them. The following diagram shows external reference design. Of course, for USB Host2.0 some signals can be removed based on different application.

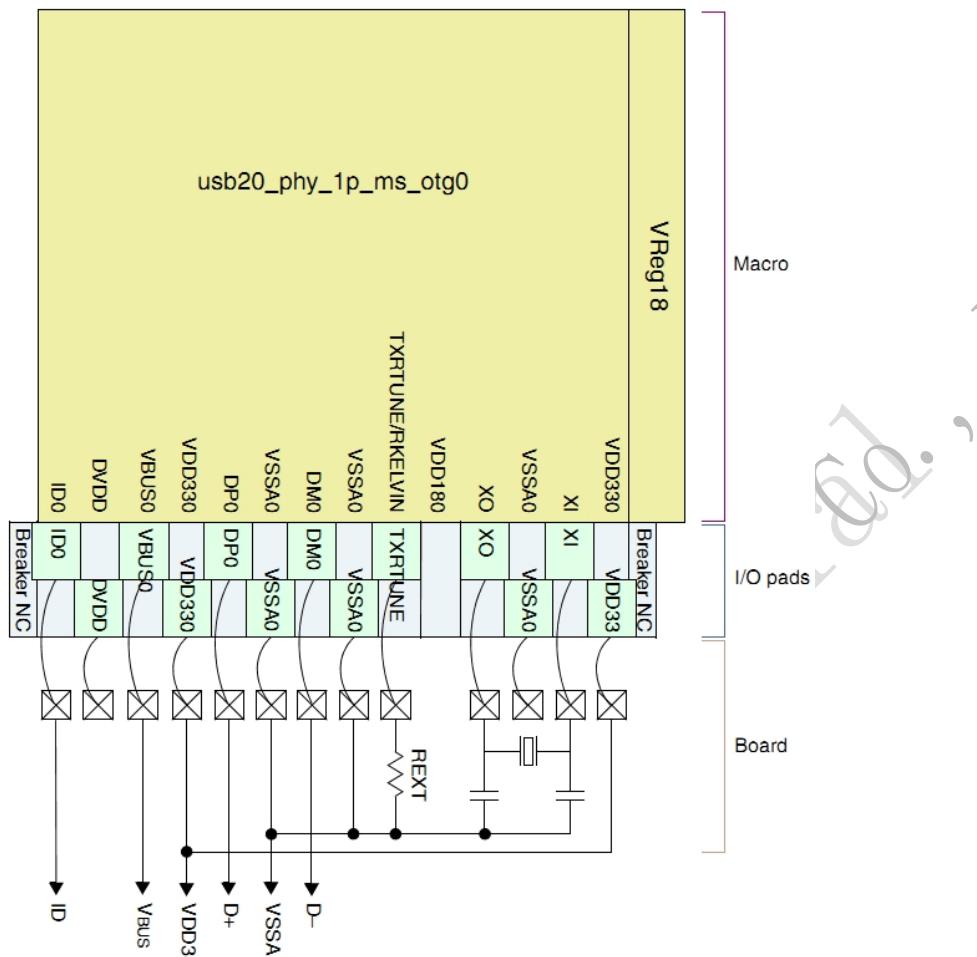


Fig. 1-9 RK3168 USB OTG/Host2.0 interface reference connection

1.6.4 RK3168 Power up/down sequence requirement

For all of the power supply in RK3168, there is no any specific requirement of power up/down sequence except power supply between core logic and DDR3/LPDDR2 IO , between USB OTG/Host2.0 power supply .

- Power supply sequence for core logic(CVDD/AVDD/PVDD) and DDR3/LPDDR2 IO (MVDD)

It is generally recommended that the core logic and DDR IO be powered-up together, and it is also acceptable for core logic supply to power-up a very short time before the DDR IO supply. If DDR IO supply must power-up before the core logic supply, it is advised to keep the time between these two events less than 100ms to limit excessive DDR IO current draws.

- Power supply sequence for core logic(CVDD/AVDD/PVDD) and digital GPIO power^①

There is no requirement on the power-up sequence for two above groups. It is generally recommended that “turn on the higher GPIO voltage first and then the lower core voltage” so that the crowbar current would not occur on the power-up stage.

There is no requirement on the power-down sequence for two above groups. Customers can decide which voltage to be down first based on the application need.

- Power supply sequence for USB OTG/Host2.0

There is no requirement on the power-down sequence for the USB groups. Customers can decide which voltage to be down first based on the application, it is recommended to keep the time between collapsing of power supplies as short as possible

Notes :^④digital GPIO power include LCD0_VCCj, LCD1_VCC, CIF_VCC, PVDD, APj_VCC, FLASH_VCC, VCCIOj.

1.6.5 RK3168 Power on reset descriptions

The following figure shows power-on-reset sequence. External power-on-reset input signal NPOR is released after stabilization of oscillator input clock XIN24M. Internal signal sysrstn is generated after NPOR is filtered glitch , which can filter out 5 clock cycles(24MHz) for low pulse of NPOR, so 208ns low pulse of NPOR will not be recognized as valid power-on-reset signal for RK3168.

To make PLLs work normally, the internal power down signal(pllpd) for PLLs must be high after power-on-reset, and maintains high level for more than 1us after sysrstn is deasserted, and PLLs start to lock when pllpd deassert, and consume about50us to lock.

The system will wait about 4096 cycles(170us) from sysrstn is de-asserted, then deactivate internal reset signal chiprstn, which is used to control generation logic of all the clock inside CRU.

After 256 cycles or about 10.7us , rstn_pre for reset signal of all internal IPs will be deasserted , in other words, about 10.7us of clock has been generated before reset of every internal module is released.

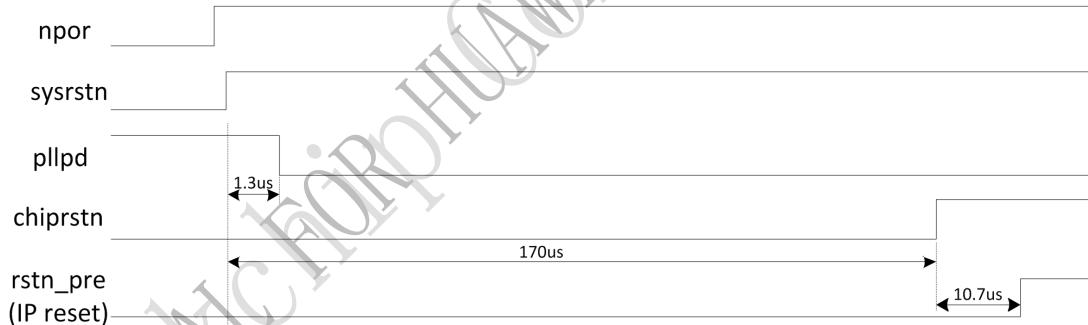


Fig. 1- 10 RK3168 reset signals sequence

Chapter 2 System Overview

2.1 Address Mapping

RK3168 support to boot from internal bootrom, which support remap function by software programming. remap is controlled by GRF_SOC_CON0 bit[12].

- remap function is disabled (default state)

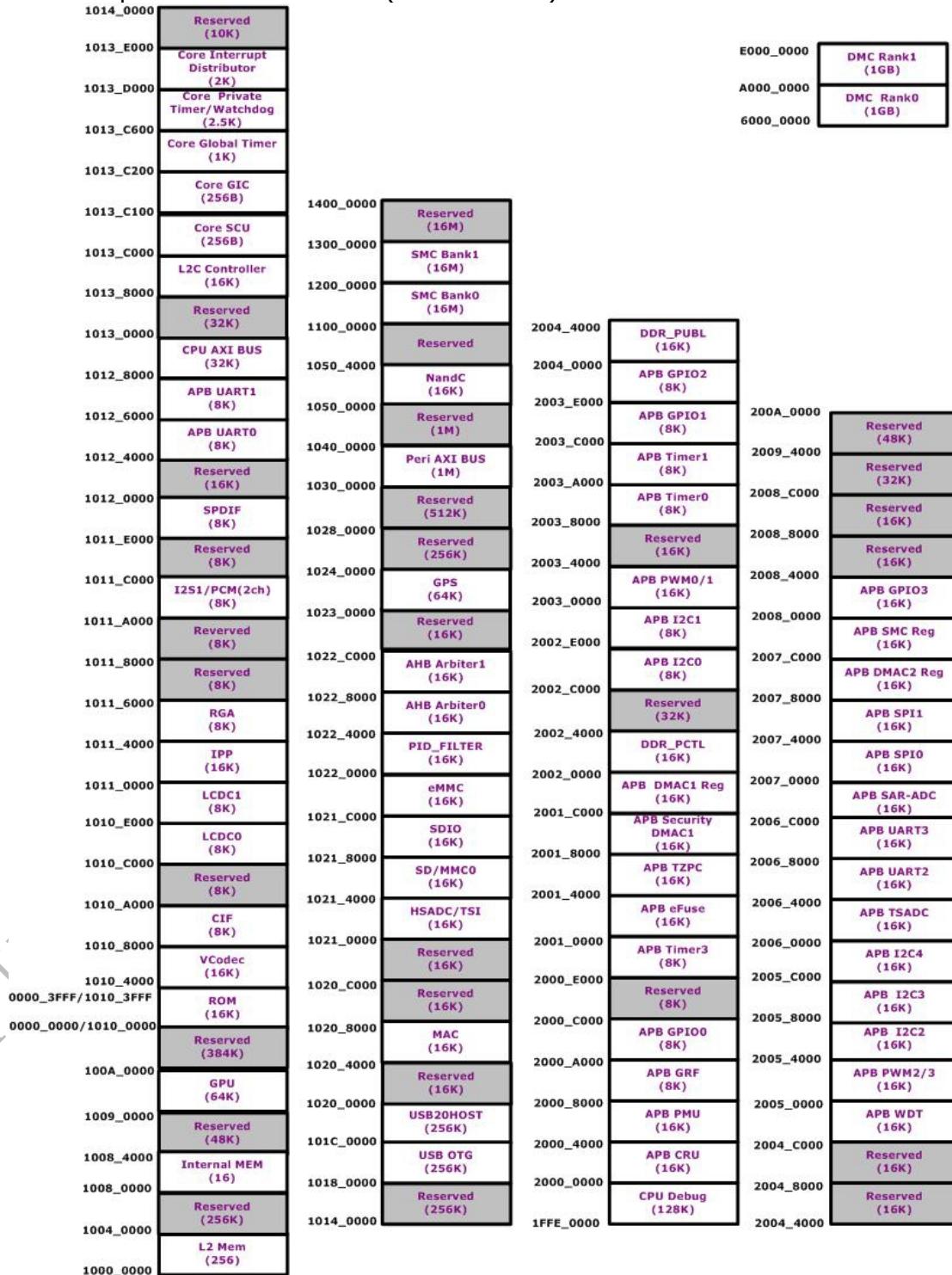


Fig. 2-1 RK3168 Address Mapping before remap

- remap function is enable

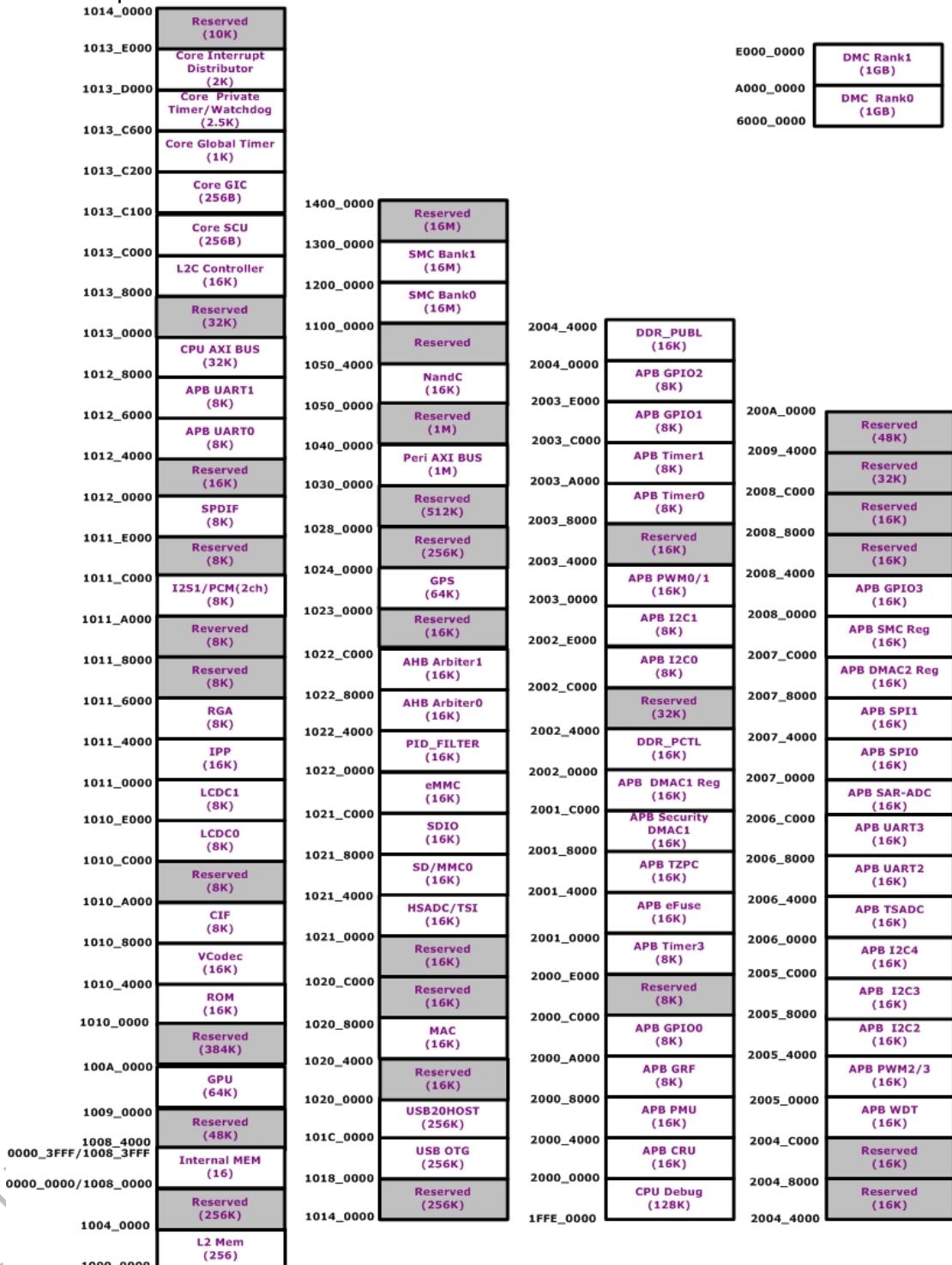


Fig. 2-2 RK3168 Address Mapping after remap

2.2 System Boot

RK3168 provides system boot from off-chip devices such as 8bits/16bits async nand flash, SPI and eMMC memory. When boot code is not ready in these devices, also provide system code download into them by USB OTG and Uart0 interface. All of the boot code will be stored in internal bootrom. The following is the whole boot procedure for boot code , which will be stored in bootromin

advance.

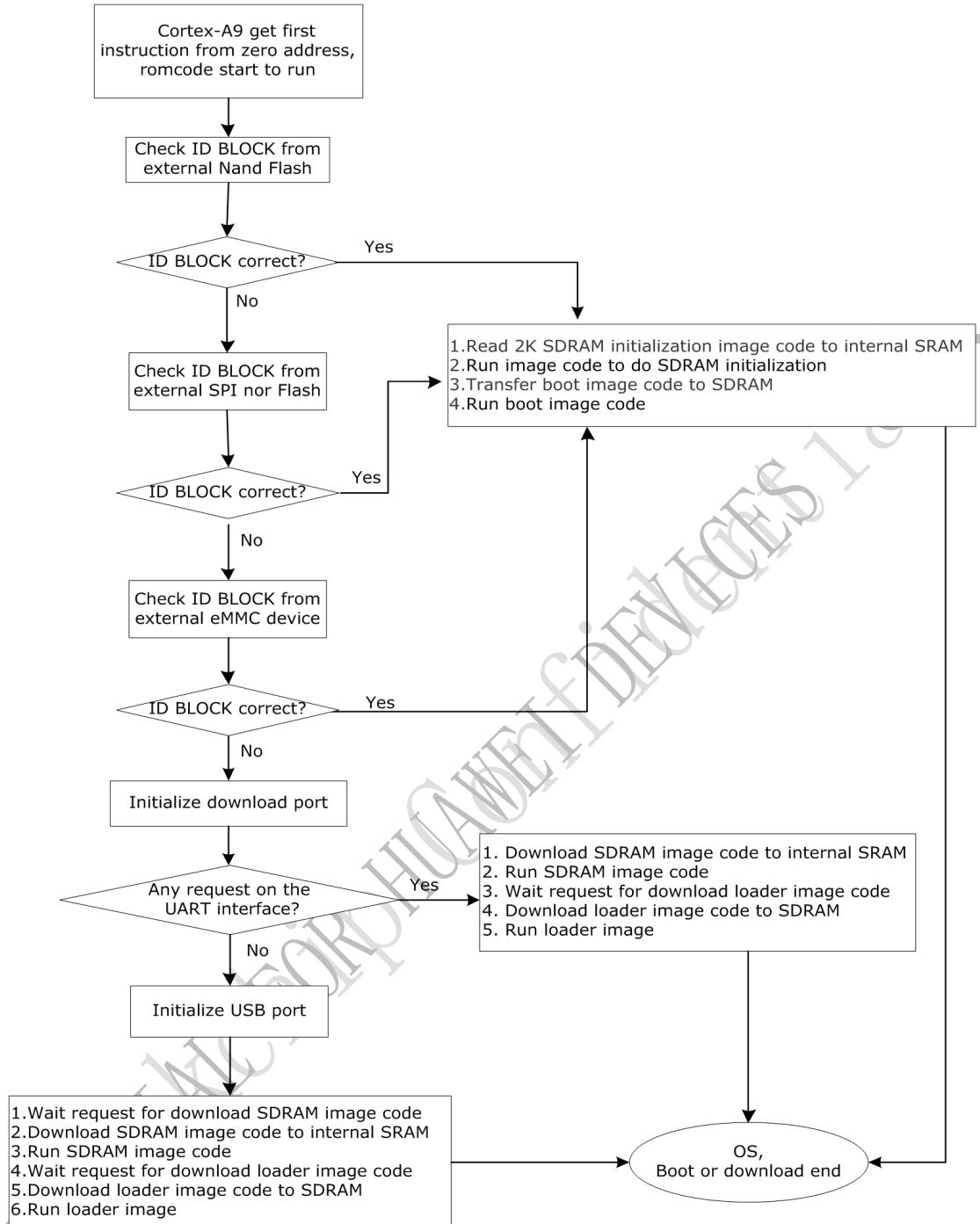


Fig. 2-3 RK3168 boot procedure flow

2.3 System Interrupt connection

RK3168 provides an general interrupt controller(GIC) for Cortex-A9 MPCore processor, which has 76 SPI interrupt sources and 3 PPI interrupt source and separately generates one nIRQ and one nFIQ to CPU. The triggered type for each interrupts is high level sensitive, not programmable. The detailed interrupt sources connection is in the following table. For detailed GIC setting, please refer to Chapter 12 .

Table 2- 1 RK3168 Interrupt connection list

IRQ Type	IRQ ID	Source(spi)	Polarity
PPI	27	Golbal Timer	High level
	29	Private Timer	High level
	30	WDT	High level
SPI	32	DMAC1(0)	High level
	33	DMAC1(1)	High level
	34	DMAC2(0)	High level
	35	DMAC2(1)	High level
	36	DDR_PCTL	High level
	37	NA	High level
	38	GPU(0)	High level
	39	NA	High level
	40	Video encoder	High level
	41	Video decoder	High level
	42	CIF	High level
	43	N/A	High level
	44	LCDC0	High level
	45	LCDC1	High level
	46	IPP	High level
	47	USB OTG	High level
	48	USB Host2.0	High level
	49	GPS	High level
	50	MAC	High level
	51	N/A	High level
	52	N/A	High level
	53	HS-ADC/TSI	High level
	54	SD/MMC0	High level
	55	SDIO	High level
	56	eMMC	High level
	57	SAR-ADC	High level
	58	NandC	High level
	59	N/A	High level
	60	SMC	High level
	61	PID_FILTER	High level
	62	N/A	High level
	63	I2S/PCM	High level
	64	SPDIF	High level
	65	UART0	High level
	66	UART1	High level
	67	UART2	High level
	68	UART3	High level
	69	SPI0	High level

	70	SPI1	High level
	71	I2C0	High level
	72	I2C1	High level
	73	I2C2	High level
	74	I2C3	High level
	75	Timer0	High level
	76	Timer1	High level
	77	Timer2	High level
	78	PWM0_IRQ	High level
	79	PWM1_IRQ	High level
	80	PWM2_IRQ	High level
	81	PWM3_IRQ	High level
	82	WDT	High level
	83	I2C4	High level
	84	PMU(0)	High level
	85	GPIO0	High level
	86	GPIO1	High level
	87	GPIO2	High level
	88	GPIO3	High level
	89	N/A	High level
	90	N/A	High level
	91	N/A	High level
	92	peri_ahb_usb arbiter	High level
	93	peri_ahb_emem arbiter	High level
	94	RGA	High level
	95	N/A	High level
	96	N/A	High level
	97	SD/MMC detect	High level
	98	SDIO detect	High level
	99	noc_6(gpu)	High level
	100	PMU(stop_exit_int)	High level
	101	observer_mainfault	High level
	102	vpu_obsrv_mainfault	High level
	103	peri_obsrv_mainfault	High level
	104	vio1_obsrv_mainfault	High level
	105	vio0_obsrv_mainfault	High level
	106	dmac_obsrv_mainfault	High level

2.4 System DMA hardware request connection

RK3168 provides 2 DMA controllers : DMAC0 inside cpu system and DMAC1 inside peri system. As for DMAC0, there are 11 hardware request ports . Another, 14 hardware request ports are used in DMAC1, the trigger type for each of them

is high level, not programmable. For detailed descriptions of DMAC0 and DMAC1, please refer to Chapter 10 and Chapter 11 .

Table 2- 2 RK3168 DMAC0 Hardware request connection list

Req Number	Source	Polarity
0	Uart0 tx	High level
1	Uart0 rx	High level
2	Uart1 tx	High level
3	Uart1 rx	High level
4	NA	High level
5	NA	High level
6	I2S1/PCM(2ch) tx	High level
7	I2S1/PCM(2ch) rx	High level
8	SPDIF tx	High level
9	NA	High level
10	NA	High level

Table 2- 3 RK3168 DMAC1 Hardware request connection list

Req Number	Source	Polarity
0	HS-ADC/TSI	High level
1	SD/MMC	High level
2	N/A	High level
3	SDIO	High level
4	eMMC	High level
5	PID_FILTER	High level
6	Uart2 tx	High level
7	Uart2 rx	High level
8	Uart3 tx	High level
9	Uart3 rx	High level
10	SPI0 tx	High level
11	SPI0 rx	High level
12	SPI1 tx	High level
13	SPI1 rx	High level

Chapter 3 CRU (Clock & Reset Unit)

3.1 Overview

The CRU is an APB slave module that is designed for generating all of the internal and system clocks, resets of chip. CRU generates system clock from PLL output clock or external clock source, and generate system reset from external power-on-reset, watchdog timer reset or software reset.

CRU supports the following features:

- Compliance to the AMBA APB interface
- Embedded four PLL
- Support only one crystals
- Flexible selection of clock source
- Supports the respective gating of all clocks
- Supports the respective software reset of all modules

For detailed information about **CRU**, please refer to **RK3168 CRU.pdf**.

Chapter 4 PMU (Power Management Unit)

4.1 Overview

The PMU focuses on the power on/off switch for different power domain, which support the different system power saved mode to meet the chip high performance and lower power application requirement.

4.1.1 Features

- Support 3 voltage domains
- Support 6 separate power domains, which can be power up/down by software based on different application scenes
- Support seven work modes(normal mode, slow mode, idle mode, deep idle mode, stop mode, sleep mode and power off mode) to save power
- Support idle mode which only Cortex-A9 core clock gated, and wakeup by any interrupt from every on-chip component

- Support deep idle mode which only Cortex-A9 core power off, and wakeup by any interrupt from every on-chip component
- Support stop mode which almost modules clock gated, and wakeup by some peripherals or 16 different GPIOs
- Support sleep mode which the internal power is power off, and wakeup by some peripherals or 16 different GPIOs
- Support PD_CORE domain is externally turned off in sleep mode
- Support power off mode which the internal power is externally turned off, and wakeup by 16 different GPIOs
- Support clock of PD_ALIVE and PD_RTC switch to 32.768kHz optionally in some low power modes
- Support PLLs off in some low power modes
- Support OSC disable optionally in some low power modes
- Support hardware DDR self-refresh optionally in some low power modes
- Support select to boot from SRAM or ROM after wakeup in deep idle mode and sleep mode

For detailed information about **PMU**, please refer to **RK3168 PMU.pdf**.

Chapter 5 System Security

5.1 Overview

The RK3168 use the TrustZone access control scheme to support the system security application requirement.

For detailed information about **System Security**, please refer to **RK3168 System Security.pdf**.

Chapter 6 System Debug

6.1 Overview

The RK3168 use the CoreSight Technology to support real-time debug access and trace for the multi-core. A standard infrastructure is implemented for the capture and transmission of trace data, combination of multiple data streams by funneling together, and then output of data to a trace port.

6.1.1 Features

- Invasive debug with core halted
- cross-triggering, the ECT provide a standard interconnect mechanism to pass debug or profiling events around the SOC
- Trace, capture and transmission trace data using PTM and TPIU
- Real-time access system memory and peripheral register without halting the CPU, using DAP AHB master

6.1.2 Debug components address map

The following table shows the debug components address in memory map:

Module	Base Address
DAP_ROM	0x1ffe0000
CTI4	0x1ffe1000
TPIU	0x1ffe2000
Trace Funnel	0x1ffe3000
CPUDBG0	0x1ffe4000
CPUPMU0	0x1fff0000
CPUDBG1	0x1fff2000
CPUPMU1	0x1fff3000
CTI0	0x1fff8000
CTI1	0x1fff9000
PTM0	0x1fffc000
PTM1	0x1fffd000

6.2 Block Diagram

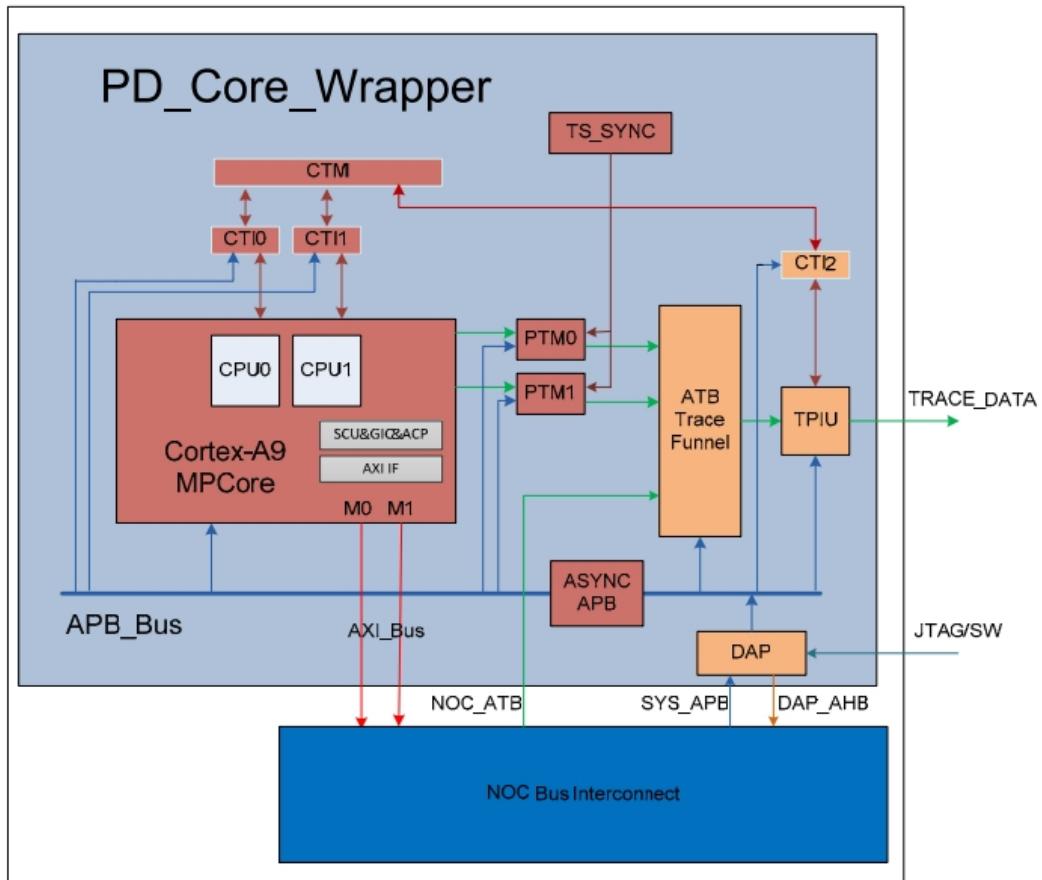


Fig. 6- 1 RK3168 Debug system structure

6.3 Function description

6.3.1 DAP

The Debug Access Port (DAP) is an implementation of an ARM Debug Interface version 5.1 (ADIV5.1) comprising a number of components supplied in a single configuration. All the supplied components fit into the various architectural components for Debug Ports (DPs), which are used to access the DAP from an external debugger and Access Ports (APs), to access on-chip system resources.

The RK3168 DAP has following components:

- Serial Wire JTAG Debug Port(SWJ-DP)
- APB Access Port(APB-AP)
- APB-Mux
- AHB Access Port(AHB-AP)
- ROM table

The debug port is the host tools interface to access the DAP-Lite. This interface controls any access ports provided within the DAP-Lite. The DAP-Lite support a combined debug port which includes both JTAG and Serial Wire Debug(SWD), with a mechanism that supports switching between them.

The APB-AP acts as a bridge between SWJ-DP and APB bus which translate the Debug request to APB bus.

The APB-Mux enables external tools and system access to the debug APB. The APB-Mux encapsulates the multiple interface into a single deliverable

component, enable multi-master access to the Debug APB.

The AHB-AP implements the MEM-AP architecture to directly connect to an AHB based memory system. Connection to other memory systems is possible through suitable bridging logic.

The DAP provides an internal ROM table connected to the master Debug APB port of the APB-Mux. The Debug ROM table is loaded at address 0x00000000 and 0x80000000 of this bus and is accessible from both APB-AP and the system APB input. Bit [31] of the address bus is not connected to the ROM Table, ensuring that both views read the same value. The ROM table stores the locations of the components on the Debug APB.

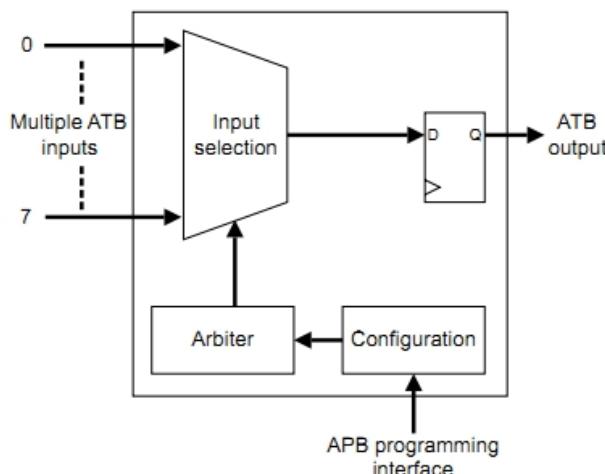
6.3.2 PTM

The PTM is a module that performs real-time instruction flow tracing based on the Program Flow Trace (PFT) architecture. The PTM generates information that trace tools use to reconstruct the execution of all or part of a program.

The PFT architecture assumes that the trace tools can access a copy of the code being traced. For this reason, the PTM generates trace only at certain points in program execution, called waypoints. This reduces the amount of trace data generated by the PTM compared to the ETM protocol. Waypoints are changes in the program flow or events, such as an exception. The trace tools use waypoints to follow the flow of program execution.

6.3.3 Trace funnel

The CSTF is used when there is more than one trace source. The CSTF combines multiple trace streams onto a single ATB bus.



6.3.4 TPIU

The TPIU acts as a bridge between the on-chip trace data, with separate IDs, to a data stream, encapsulating IDs where required, that is then captured by a Trace Port Analyzer (TPA). Figure 8-1 shows the main blocks of the TPIU and the clock domains.

The TPIU contains the following components:

- **Formatter**
Inserts source ID signals into the data packet stream so that trace data can be re-associated with its trace source. See TPIU formatter and FIFO.
- **Asynchronous FIFO**
Enables trace data to be driven out at a speed that is not dependent on the on-chip bus clock.
- **Register bank**
Contains the management, control and status registers for triggers, flushing behavior and external control.

- Trace out

The trace out block serializes formatted data before it goes off-chip.

- Pattern Generator

The pattern generator unit provides a simple set of defined bit sequences or patterns that can be output over the Trace Port and be detected by the TPA or other associated Trace Capture Device (TCD). The TCD can use these patterns to indicate if it is possible to increase or to decrease the trace port clock speed.

- ATB interface

The TPIU accepts trace data from a trace source, either direct from a trace source or using a Trace Funnel.

- APB interface

The APB interface is the programming interface for the TPIU.

6.3.5 ECT (CTI & CTM)

The ECT for CoreSight consists of a number of CTIs and CTMs connected together. This enables ARM/ETM subsystems to interact. That is cross trigger, with each other. The debug system enables debug support for multiple cores, together with cross triggering between the cores and their respective ETMs.

The main function of the ECT (CTI and CTM) is to pass debug events from onecore to another. For example, the ECT can communicate debug state information from one core to another, so that program execution on both processors can be stopped at the same time if required.

- CTI (Cross Trigger Interface)

The CTI combines and maps the trigger requests, and broadcasts them to all other interfaces on the ECT as channel events. When the CTI receives a channel event it maps this onto a trigger output. This enables subsystems to cross trigger with each other. The receiving and transmitting of triggers is performed through the trigger interface.

- CTM (Cross Trigger Matrix)

This block controls the distribution of channel events. It provides Channel Interfaces (CIs) for connection to either CTIs or CTMs. This enables multiple CTIs to be linked together.

6.4 Register description

6.4.1 DAP APB-AP register summary

Name	Offset	Size	Reset Value	Description
DAP_CSW	0x000	W	0x00000002	Control/Status Word, CSW
DAP_TAR	0x004	W	0x00000000	Transfer Address, TAR
Reserved	0x008	W	NA	Reserved
DAP_DRW	0x00c	W	NA	Data Read/Write, DRW
DAP_BD0	0x010	W	NA	Bank Data 0, BD0
DAP_BD1	0x014	W	NA	Bank Data 1, BD1
DAP_BD2	0x018	W	NA	Bank Data 2, BD2
DAP_BD3	0x01c	W	NA	Bank Data 3, BD3
Reserved	0x20-0xf4	W	NA	Reserved
DAP_ROM_ADDR	0xf8	W	NA	Debug ROM Address, ROM
DAP_IDR	0xfc	W	0x14770002	Identification Register, IDR

6.4.2 DAP APB-AP Detailed Register Description

DAP_CSW

Address: APBAP_BASE + offset(0x000)

Control/Status Word

Bits	Attr	Reset Value	Description
31	RW	0x0	<p>Software access enable. Drives DBGSWENABLE to enable or disable software access to the Debug APBbus in the APB multiplexor. b1 = Enable software access b0 = Disable software access. Reset value = b0. On exit from reset, defaults to b1 to enable software access.</p>
31:12	RW	0x0	Reserved
11:8	R	0x0	<p>Specifies the mode of operation. b0000 = Normal download/upload model b0001-b1111 = Reserved Reset value = b0000.</p>
7	R	0x0	<p>Transfer in progress. This field indicates if a transfer is currently in progress on the APB master port.</p>
6	R	0x0	<p>Transfer in progress. This field indicates if a transfer is currently in progress on the APB master port.</p> <p>Indicates the status of the DEVICEEN input.</p> <ul style="list-style-type: none"> • If APB-AP is connected to the Debug APB, that is, a bus connected only to debug and trace components, it must be permanently enabled by tying DEVICEEN HIGH. This ensures that trace components can still be programmed when DBGGEN is LOW. In practice, it is expected that the APB-AP is almost always used in this way. • If APB-AP is connected to a system APB dedicated to the non-secure world, DEVICEEN must be connected to DBGGEN. • If APB-AP is connected to a system APB dedicated to the secure world, DEVICEEN must be connected to SPIDEN.
5:4	RW	0x0	<p>Auto address increment and packing mode on Read or Write data access. Does not increment if the transaction completes with an error response or the transaction is aborted. Auto address incrementing is not performed on access to banked data registers 0x10-0x1C. The status of these bits is ignored in these cases.</p> <p>b11 = Reserved b10 = Reserved b01 = Increment b00 = Auto increment OFF. Increment occurs in word steps.</p>

			Reset value = b00.
3	R	0x0	Reserved
2:0	R	0x2	Size of the access to perform. Fixed at b010 = 32 bits. Reset value = b010.

DAP_TAR

Address: APBAP_BASE + offset(0x004)

Transfer Address

Bits	Attr	Reset Value	Description
31:2	RW	0x0	Address[31:2] of the current transfer PADDR[31:2]=TAR[31:2] for accesses from Data Read/Write Register at 0x0C. PADDR[31:2]=TAR[31:4]+DAPADDR[3:2] for accesses from Banked Data Registers at 0x10-0x1C and 0x0C.
1:0	R	0x0	Reserved

DAP_DRW

Address: APBAP_BASE + offset(0x00c)

Data Read/Write

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Write mode: Data value to write for the current transfer. Read mode: Data value read from the current transfer.

DAP_BD0-DAP_BD3

Address: APBAP_BASE + offset(0x010) - APBAP_BASE + offset(0x01c)

Bank Data 0-3

Bits	Attr	Reset Value	Description
31:0	RW	0x0	If DAPADDR[7:4] = 0x0001, so accessing APB-AP registers in the range 0x10-0x1C, then the derived PADDR[31:0] is: <ul style="list-style-type: none"> • Write mode: Data value to write for the current transfer to external address TAR[31:4]+DAPADDR[3:2] + 2'b00. • Read mode: Data value read from the current transfer from external address TAR[31:4]+DAPADDR[3:2] + 2'b00. Auto address incrementing is not performed on DAP accesses to BD0-BD3. Reset value = 0x00000000

DAP_ROM_ADDR

Address: 0xf8

ROM address

Bits	Attr	Reset Value	Description
31:12	R	0x800000	Base address of the ROM Table The ROM provides a look-up table of allCoreSight Debug APB components. Read only. Set to 0xFFFF if no ROM is present. In the initial CoreSight release this must

			be set to 0x80000.
11:0	R	0x000	Set to 0x000 if ROM is present. Set to 0xFFFF if ROM table is not present. In the initial CoreSight release this must be set to 0x000.

DAP_IDR

Address: APBAP_BASE + offset(0x0fc)

Bits	Attr	Reset Value	Description
31:28	R	0x1	Revision. Reset value is 0x1 for APB-AP.
27:24	R	0x4	JEDEC bank. 0x4 indicates ARM Limited.
23:17	R	0x3b	JEDEC code. 0x3B indicates ARM Limited.
16	R	0x1	Memory AP. 0x1 indicates a standard register map is used.
15:8	R	0x00	Reserved
7:0	R	0x02	Identity value. Reset value is 0x02 for APB-AP.

6.4.3 DAP AHB-AP register summary

Name	Offset	Size	Reset Value	Description
DAP_AHB_CSW	0x000	W	0x00000002	Control/Status Word, CSW
DAP_AHB_TAR	0x004	W	0x00000000	Transfer Address, TAR
Reserved	0x008	W	NA	Reserved
DAP_AHB_DRW	0x00c	W	NA	Data Read/Write, DRW
DAP_AHB_BD0	0x010	W	NA	Bank Data 0, BD0
DAP_AHB_BD1	0x014	W	NA	Bank Data 1, BD1
DAP_AHB_BD2	0x018	W	NA	Bank Data 2, BD2
DAP_AHB_BD3	0x01c	W	NA	Bank Data 3, BD3
Reserved	0x20-0xf7	W	NA	Reserved
DAP_DEBUG_ROM	0xf8	W	NA	Debug ROM table
DAP_AHB_IDR	0xfc	W	0x14770002	Identification Register, IDR

6.4.4 DAP AHB-AP Detailed Register Description

DAP_AHB_CSW

Address: AHBAP_BASE + offset(0x000)

Control/Status Word

Bits	Attr	Reset Value	Description
31	-	-	Reserved
30	RW	0x0	<p>Specifies that a secure transfer is requested. SProt HIGH indicates a non-secure transfer. SProt LOW indicates a secure transfer.</p> <ul style="list-style-type: none"> If this bit is LOW, and SPIDEN is HIGH, HPROT[6] is asserted LOW on an AHB transfer. If this bit is LOW, and SPIDEN is LOW, HPROT[6] is asserted HIGH and the AHB transfer is not initiated. If this bit is HIGH, the state of SPIDEN is ignored. HPROT[6] is HIGH.

			Reset value = b1. Non-secure
29	-	-	Reserved
28:24	RW	0x0	Specifies the protection signal encoding to be output on HPROT[4:0].
23	RO	0x0	Indicates the status of the SPIDEN port. If SPIStatus is LOW, no secure AHB transfers are carried out.
22:12	-	-	Reserved
11:8	RW	0x0	Specifies the mode of operation. b0000 = Normal download/upload model b0001-b1111 = Reserved
7	RO	0x0	Transfer in progress. This field indicates if a transfer is currently in progress on the AHB master port
6	RO	0x0	Indicates the status of the DBGGEN port. If DbgStatus is LOW, no AHB transfers are carried out. 1 = AHB transfers permitted. 0 = AHB transfers not permitted.
5:4	RW	0x0	Auto address increment and packing mode on Read or Write data access. Only increments if the current transaction completes without an Error response and the transaction is not aborted. Auto address incrementing and packed transfers are not performed on access to Banked Data registers 0x10-0x1C. The status of these bits is ignored in these cases. Increments and wraps within a 1KB address boundary, for example, for word incrementing from 0x1400-0x17FC. If the start is at 0x14A0, then the counter increments to 0x17FC, wraps to 0x1400, then continues incrementing to 0x149C. b00 = Auto increment OFF. b01 = Increment, single. Single transfer from corresponding byte lane. b10 = Increment, packed Word = Same effect as single increment. Byte/Halfword: Packs four 8-bit transfers or two 16-bit transfers into a 32-bit DAP transfer. Multiple transactions are carried out on the AHB interface. b11 = Reserved SBZ, no transfer. Size of address increment is defined by the Size field, bits [2:0].
3	-	-	Reserved
2:0	RW	0x2	Size of the data access to perform: b000 = 8 bits b001 = 16 bits b010 = 32 bits b011-b111 = Reserved

DAP_AHB_TAR

Address: AHBAP_BASE + offset(0x004)

Control/Status Word

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Address of the current transfer.

DAP_AHB_DRW

Address: AHBAP_BASE + offset(0x00c)

Control/Status Word

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Write mode: Data value to write for the current transfer. Read mode: Data value read from the current transfer.

DAP_AHB_BD0- DAP_AHB_BD3

Address: APBAP_BASE + offset(0x010) - APBAP_BASE + offset(0x01c)

Bank Data 0-3

Bits	Attr	Reset Value	Description
31:0	RW	0x0	If DAPADDR[7:4] = 0x0001, so accessing AHB-AP registers in the range 0x10-0x1C, then the derived HADDR[31:0] is: <ul style="list-style-type: none"> • Write mode: Data value to write for the current transfer to external address TAR[31:4]+DAPADDR[3:2] + 2'b00. • Read mode: Data value read from the current transfer from external address TAR[31:4]+DAPADDR[3:2] + 2'b00. Auto address incrementing is not performed on DAP accesses to BD0-BD3. Banked transfers are only supported for word transfers. Non-word banked transfers are reserved and unpredictable. Transfer size is currently ignored for banked transfers

DAP_DEBUG_ROM

Address: 0xf8

ROM address

Bits	Attr	Reset Value	Description
31:0	RO	-	Base address of a ROM table. The ROM provides a look-up table for system components. Set to 0xFFFFFFFF in the AHB-AP in the initial release

DAP_AHB_IDR

Address: APBAP_BASE + offset(0x0fc)

Bits	Attr	Reset Value	Description
31:28	R	0x4	Revision. Reset value is 0x4 for AHB-AP.
27:24	R	0x4	JEDEC bank. 0x4 indicates ARM Limited.
23:17	R	0x3b	JEDEC code. 0x3B indicates ARM Limited.
16	R	0x1	Memory AP. 0x1 indicates a standard register map is used.
15:8	R	0x00	Reserved

7:0	R	0x01	Identity value. Reset value is 0x01 for AHB-AP.
-----	---	------	---

6.4.5 DAP-ROM register summary

Name	Offset	Size	Reset Value	Description
DAP_ROMENTRY0	0x0000	W	0x00001003	CTI4 entry register
DAP_ROMENTRY1	0x0004	W	0x00002003	TPIU entry register
DAP_ROMENTRY2	0x0008	W	0x00003003	Trace Funnel register
DAP_ROMENTRY3	0x000c	W	0x00004003	Cortex-A9 ROM entry register
DAP_ROM_PERIPHID4	0x0fd0	W	0x00000004	Peripheral ID4
DAP_ROM_PERIPHID5	0x0fd4	W	0x00000000	Peripheral ID5
DAP_ROM_PERIPHID6	0x0fd8	W	0x00000000	Peripheral ID6
DAP_ROM_PERIPHID7	0x0fdc	W	0x00000000	Peripheral ID7
DAP_ROM_PERIPHID0	0x0fe0	W	0x000000c4	Peripheral ID0
DAP_ROM_PERIPHID1	0x0fe4	W	0x000000b4	Peripheral ID1
DAP_ROM_PERIPHID2	0x0fe8	W	0x0000006b	Peripheral ID2
DAP_ROM_PERIPHID3	0x0fec	W	0x00000020	Peripheral ID3
DAP_ROM_COMPONID0	0x0ff0	W	0x0000000d	Component ID0
DAP_ROM_COMPONID1	0x0ff4	W	0x00000010	Component ID1
DAP_ROM_COMPONID2	0x0ff8	W	0x00000005	Component ID2
DAP_ROM_COMPONID3	0x0ffc	W	0x000000b1	Component ID3

6.4.6 DAP-ROM Detailed Register Description

DAP_ROMENTRY0

Address: DAPROM_BASE + offset(0x0000)

TPIU entry register

Bits	Attr	Reset Value	Description
31:0	R	0x00001003	TPIU entry register

DAP_ROMENTRY1

Address: DAPROM_BASE + offset(0x0004)

Cortex-A9 Debug entry register

Bits	Attr	Reset Value	Description
31:0	R	0x00002003	Cortex-A9 Debug entry register

DAP_ROMENTRY2

Address: DAPROM_BASE + offset(0x0008)

Cortex-A9 ETM entry register

Bits	Attr	Reset Value	Description
31:0	R	0x00003003	Cortex-A9 ETM entry register

DAP_ROMENTRY3

Address: DAPROM_BASE + offset(0x000c)

Cortex-A9 CTI entry register

Bits	Attr	Reset Value	Description
31:0	R	0x00004003	Cortex-A9 CTI entry register

DAP_ROM_PERIPHID4

Address: DAPROM_BASE + offset(0x0fd0)

Peripheral ID4

Bits	Attr	Reset Value	Description
31:0	R	0x00000004	Peripheral ID4

DAP_ROM_PERIPHID5

Address: DAPROM_BASE + offset(0x0fd4)

Peripheral ID5

Bits	Attr	Reset Value	Description
31:0	R	0x00000000	Peripheral ID5

DAP_ROM_PERIPHID6

Address: DAPROM_BASE + offset(0x0fd8)

Peripheral ID6

Bits	Attr	Reset Value	Description
31:0	R	0x00000000	Peripheral ID6

DAP_ROM_PERIPHID7

Address: DAPROM_BASE + offset(0x0fdc)

Peripheral ID7

Bits	Attr	Reset Value	Description
31:0	R	0x00000000	Peripheral ID7

DAP_ROM_PERIPHID0

Address: DAPROM_BASE + offset(0x0fe0)

Peripheral ID0

Bits	Attr	Reset Value	Description
31:0	R	0x000000c4	Peripheral ID0

DAP_ROM_PERIPHID1

Address: DAPROM_BASE + offset(0x0fe4)

Peripheral ID1

Bits	Attr	Reset Value	Description
31:0	R	0x000000b4	Peripheral ID1

DAP_ROM_PERIPHID2

Address: DAPROM_BASE + offset(0x0fe8)

Peripheral ID2

Bits	Attr	Reset Value	Description
31:0	R	0x00000006b	Peripheral ID2

DAP_ROM_PERIPHID3

Address: DAPROM_BASE + offset(0x0fec)

Peripheral ID3

Bits	Attr	Reset Value	Description
31:0	R	0x00000020	Peripheral ID3

DAP_ROM_COMPONIDO

Address: DAPROM_BASE + offset(0x0ff0)

Component ID0

Bits	Attr	Reset Value	Description
31:0	R	0x0000000d	Component ID0

DAP_ROM_COMPONID1

Address: DAPROM_BASE + offset(0x0ff4)

Component ID0

Bits	Attr	Reset Value	Description
31:0	R	0x00000010	Component ID1

DAP_ROM_COMPONID2

Address: DAPROM_BASE + offset(0x0ff8)

Component ID0

Bits	Attr	Reset Value	Description
31:0	R	0x00000005	Component ID2

DAP_ROM_COMPONID3

Address: DAPROM_BASE + offset(0x0ffc)

Component ID0

Bits	Attr	Reset Value	Description
31:0	R	0x000000b1	Component ID3

6.4.7 PTM register summary

Name	Offset	Size	Reset Value	Description
PTM_ETMCR	0x0	W	0x401	Main control
PTM_ETMCCR	0x4	W	0x8d294004	Configuration code
PTM_ETMTE	0x8	W	0x0	Trigger event
PTM_ETMSR	0x10	W	0x0	Status
PTM_ETMSCR	0x14	W	0x0	System configuration
PTM_ETMTSSCR	0x18	W	0x0	TraceEnable Start/Stop control
PTM_ETMTEE	0x20	W	0x0	TraceEnable event
PTM_ETMTECR1	0x24	W	0x0	TraceEnable Control
PTM_ETMACVR1-8	0x40-0x5c	W	0x0	Address comparator value
PTM_ETMACTR1-8	0x80-0x9c	W	0x0	Address comparator access type
PTM_ETMCNTRLDV R1-2	0x140-0x144	W	0x0	Counter load value
PTM_ETMCNTENR1-2	0x150-0x154	W	0x0	Counter enable
PTM_ETMCNTRLDE VR1-2	0x160-0x164	W	0x0	Counter reload event
PTM_ETMCNTVR1-2	0x170-0x174	W	0x0	Counter value
PTM_SSTE1-SSTE6	0x180-0x194	W	0x0	Sequencer status transition event
PTM_CSS	0x19c	W	0x0	Current sequencer state

PTM_EOE1- PTM_EOE2	0x1a0- 0x1a4	W	0x0	External output event
PTM_CICV1	0x1b0	W	0x0	Context ID comparator value
PTM_CICM	0x1bc	W	0x0	Context ID comparator mask
PTM_ETMSYNCFR	0x1e0	W	0x0	Synchronization frequency
PTM_ETMIDR	0x1e4	W	0x411cf301	ID register
PTM_ETMCCER	0x1e8	W	0x00c019a2	Configuration code extension
PTM_ETMEXTINSEL R	0x1ec	W	0x0	Extended external input selection
PTM_TE	0x1f8	W	0x0	Timestamp Event
PTM_ETMAUXCR	0x1fc	W	0x0	Auxiliary control register
PTM_ETMTRACEID R	0x200	W	0x0	CoreSight trace ID
PTM_OSLSR	0x304	W	0x0	OS lock status
PTM_ETMPDSR	0x314	W	0x1	Device power-down status
PTM_ITMISCOU T	0xedc	W	0x0	Miscellaneous outputs
PTM_ITMISCIN	0xee0	W	0x0	Miscellaneous inputs
PTM_ITTRIGGER	0xee8	W	0x0	Trigger register
PTM_ITATBDA TA0	0xec	W	0x0	ATB data 0
PTM_ITATBCTR 2	0xef0	W	0x0	ATB control 2
PTM_ITATBID	0xef4	W	0x0	ATB identification
PTM_ITATBCTR 0	0xef8	W	0x0	ATB control 0
PTM_ETMITCTRL	0xf00	W	0x0	Integration mode control
PTM_AS	0xfb8	W	0x0	Authentication status
PTM_DC	0xfc8	W	0x0	Device configuration
PTM_DT	0xfc	W	0x0	Device type
PTM_PID4	0xfd0	W	0x4	Peripheral ID4
PTM_PID5	0xfd4	W	0x0	Peripheral ID5
PTM_PID6	0xfd8	W	0x0	Peripheral ID6
PTM_PID7	0fdc	W	0x0	Peripheral ID7
PTM_PID0	0xfe0	W	0x50	Peripheral ID0
PTM_PID1	0xfe4	W	0xb9	Peripheral ID1
PTM_PID2	0xfe8	W	0x1b	Peripheral ID2
PTM_PID3	0fec	W	0x0	Peripheral ID3
PTM_CID0	0xff0	W	0xd	Component ID0
PTM_CID1	0xff4	W	0x90	Component ID1
PTM_CID2	0xff8	W	0x5	Component ID2
PTM_CID3	0ffc	W	0xb1	Component ID3

6.4.8 PTM Detailed Register Description

PTM_ETMCR

Address: PTM_BASE + offset(0x000)

Main Control Register

Bits	Attr	Reset Value	Description
31:30	-	-	Reserved
29	RW	0x0	Return stack enable b0 = disabled b1 = enabled
28	RW	0x0	Timestamp enable b0 = disabled

			b1 = enabled
27:25	RW	0x0	Processor select
24	R	0x0	Reserved
23:16	-	-	Reserved
15:14	RW	0x0	ContextIDSize b00 = no context ID tracing b01 = context ID bits [7:0] traced b10 = context ID bits [15:0] traced b11 = context ID bits [31:0] traced. On reset, this bit is set to b00, no context ID tracing
13	-	-	Reserved
12	RW	0x0	CycleAccurate b0 = cycle counting disabled b1 = cycle counting enabled On reset this bit is set to b0, no cycle counting.
11	-	-	Reserved
10	RW	0x1	Programming Bit This bit must be set to b1 when the PTM is being programmed, see Modes of operation on page 2-3. On a PTM reset this bit is set to b1.
9	RW	0x0	Debug request control When set to b1 and the trigger event occurs, the PTMDBGRQ output is asserted until PTMDBGACK is observed. This enables a debugger to force the processor into Debug state. On PTM reset this bit is set to b0
8	RW	0x0	Branch Output When this bit is set to b1, addresses are output for all executed branches, both direct and indirect. On PTM reset this bit is set to b0.
7	R	0x0	Stall processor
6:1	-	-	Reserved
0	RW	0x1	PowerDown This bit enables external control of the PTM. This bit must be cleared by the trace software tools at the beginning of a debug session. When this bit is set to b0, both the PTM and the trace interface in the processor are enabled. To avoid corruption of trace data, this bit must not be set before the Programming Status bit in the PTM Status Register has been read as 1. On PTM reset this bit is set to b1.

PTM_ETMCCR

Address: PTM_BASE + offset(0x004)

Configuration Code Register

Bits	Attr	Reset Value	Description
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31	RO	0x1	ID Register present Indicates that the ID Register is present.
30:28	-	-	Reserved
27	RO	0x1	Software access Indicates that software access is supported
26	RO	0x1	Trace stop/start block Indicates that the trace start/stop block is present.
25:24	RO	0x1	Number of Context ID comparators Specifies the number of Context ID comparators, one.
23	RO	0x0	FIFOFULL logic Indicates that it is not possible to stall the processor to prevent FIFO overflow
22:20	RO	0x2	Number of external outputs Specifies the number of external outputs, two.
19:17	RO	0x4	Number of external inputs Specifies the number of external inputs, four.
16	RO	0x1	Sequencer Indicates that the sequencer is present
15:13	RO	0x2	Number of counters Specifies the number of counters, two.
12:4	-	-	Reserved
3:0	RO	0x4	Number of pairs of address comparators Specifies the number of address comparator pairs, four.

PTM_ETMSCR

Address: PTM_BASE + offset(0x014)

System Configuration Register

Bits	Attr	Reset Value	Description
31:15	-	-	Reserved
14:12	RO	-	Number of supported processors minus 1.The value of this field is set by the MAXCORES[2:0] input to the PTM
11:9	-	-	Reserved
8	RO	-	Read Only, as b0 - FIFOFULL is not supported.
7:0	-	-	Reserved

PTM_ETMTSSCR

Address: PTM_BASE + offset(0x018)

TraceEnable Start/Stop Control Register

Bits	Attr	Reset Value	Description
31:24	-	-	Reserved
23:16	RW	0x0	When a bit is set to 1, it selects a single address comparator (8-1) as a stop address for the TraceEnable Start/Stop block. For example, if you set bit [16] to 1 it selects single address comparator 1 as a stop address.
15:8	-	-	Reserved

7:0	RW	0x0	When a bit is set to 1, it selects a single address comparator (8-1) as a start address for the TraceEnable Start/Stop block. For example, if you set bit [0] to 1 it selects single address comparator 1 as a start address.
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PTM_ETMTECR1

Address: PTM_BASE + offset(0x024)

TraceEnable Control Register1

Bits	Attr	Reset Value	Description
31:26	-	-	Reserved
25	RW	0x0	Trace start/stop control enable. The possible values of this bit are: 0 Tracing is unaffected by the trace start/stop logic. 1 Tracing is controlled by the trace on and off addresses configured for the trace start/stop logic. The trace start/stop resource is not affected by the value of this bit.
24	RW	0x0	Exclude/include flag. The possible values of this bit are: 0 Include. The specified address range comparators indicate the regions where tracing can occur. No tracing occurs outside this region. 1 Exclude. The specified address range comparators indicate regions to be excluded from the trace. When outside an exclude region, tracing can occur
23:4	-	-	Reserved
3:0	RW	0x0	When a bit is set to 1, it selects an address range comparator, 4-1, for include/exclude control. For example, bit [0] set to 1 selects address range comparator 1

PTM_ETMACVR1-8

Address: PTM_BASE + offset(0x040-0x05c)

ETMACVR1-8

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Address comparator value register

PTM_ETMACTR1-8

Address: PTM_BASE + offset(0x080-0x09c)

ETMACTR1-8

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Address comparator access type register

PTM_ETMCNTRLDVR1-2

Address: PTM_BASE + offset(0x140-0x144)

ETMCNTRLDVR1-2

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Reload value

PTM_ETMCNTENR1-2

Address: PTM_BASE + offset(0x150-0x154)

ETMCNTENR1-2

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Enable Event

PTM_ETMCNTRLDEVR1-2

Address: PTM_BASE + offset(0x160-0x164)

ETMCNTRLDEVR1-2

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Reload Event

PTM_ETMCNTVR1-2

Address: PTM_BASE + offset(0x160-0x164)

ETMCNTVR1-2

Bits	Attr	Reset Value	Description
31:0	RW	0x0	Value

PTM_ETMSYNCFR

Address: PTM_BASE + offset(0x1e0)

Bits	Attr	Reset Value	Description
31:0	RW	0x0	The ETMSYNCFR holds the trace synchronization frequency value. Bits [2:0] of this register are not implemented and read as zero (RAZ).

PTM_ETMIDR

Address: PTM_BASE + offset(0x1e4)

Bits	Attr	Reset Value	Description
31:24	RO	0x41	Implementor code. This field reads as 0x41, ASCII code for A, indicating ARM Limited.
23:20	-	-	Reserved
19	RO	0x1	Support for Security Extensions. The value of this bit is 1, indicating that the processor implements the ARM architecture Security Extensions.
18	RO	0x1	Support for 32-bit Thumb instructions. The value of this bit is 1, indicating that a 32-bit Thumb instruction is traced as a single instruction.
17:12	-	-	Reserved
11:8	RO	0x3	Major architecture version number.
7:4	RO	0x0	Major architecture version number.
3:0	RO	-	Implementation revision

PTM_ETMCCER

Address: PTM_BASE + offset(0x1e8)

Bits	Attr	Reset Value	Description
31:26	RO	0x0	Reserved
25	RO	0x0	Timestamps not generated for DMB/DSB.
24	RO	0x0	MB/DSB instructions are not treated as waypoints.
23	RO	0x1	Return stack implemented.
22	RO	0x1	Timestamping implemented.
21:16	-	-	Reserved
15:13	RO	0x0	Specifies the number of instrumentation resources.
12	-	-	Reserved
11	RO	0x1	b1 - Indicates that all registers, except some Integration Test Registers, are readable.
10:3	RO	0x34	Specifies the size of the extended external input bus, 52.
2:0	RO	0x2	Specifies the number of extended external input selectors, 2.

PTM_ETMEXTINSELR

Address: PTM_BASE + offset(0x1ec)

Bits	Attr	Reset Value	Description
31:14	-	-	Reserved
13:8	RW	0x0	Second extended external input selector
7:6	-	-	Reserved
5:0	RW	0x0	First extended external input selector

PTM_ETMAUXCR

Address: PTM_BASE + offset(0x1fc)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3	RW	0x0	Force insertion of synchronization packets, regardless of current trace activity. Possible values for this bit are: b0 = Synchronization packets delayed when trace activity is high. This is the reset value. b1 = Synchronization packets inserted regardless of trace activity. This bit might be set if synchronization packets occur too far apart. Setting this bit might cause the trace FIFO to overflow more frequently when trace activity is high.
2	RW	0x0	Specifies whether the PTM issues waypoint update packets if there are more than 4096 bytes between waypoints. Possible values for this bit are: b0 = PTM always issues update packets if there are more than 4096 bytes between waypoints. This is the reset value. b1 = PTM does not issue waypoint update packets unless required to do so as the result of

			an exception or debug entry.
1	RW	0x0	Specifies whether the PTM issues a timestamp on a barrier instruction. Possible values for this bit are: b0 = PTM issues timestamps on barrier instructions. This is the reset value. b1 = PTM does not issue timestamps on barriers
0	RW	0x0	Specifies whether the PTM enters overflow state when synchronization is requested, and the previous synchronization sequence has not yet completed. This does not affect entry to overflow state when the FIFO becomes full. Possible values for this bit are: b0 = Forced overflow enabled. This is the reset value. b1 = Forced overflow disabled

PTM_ETMTRACEIDR

Address: PTM_BASE + offset(0x200)

Bits	Attr	Reset Value	Description
31:7	-	-	Reserved
6:0	RW	0x0	Before trace is generated, you must program this register with a non-reserved value. Reserved values are 0x00 and any value in the range 0x70-0x7F. The reset value of this register is 0x00

PTM_ETMPDSR

Address: PTM_BASE + offset(0x314)

Bits	Attr	Reset Value	Description
31:0	RO	0x1	This register always reads as 0x00000001, indicating that the PTM Trace Registers can be accessed.

PTM_OSLSR

Address: PTM_BASE + offset(0x304)

Bits	Attr	Reset Value	Description
31:0	RO	0x0	For the PTM, the OSLSR Reads As Zero (RAZ) to show that OS Locking is not implemented.

PTM_ITMISCOUT

Address: PTM_BASE + offset(0xedc)

Bits	Attr	Reset Value	Description
31:10	-	-	Reserved
9:8	WO	0x0	Drives the PTMEXTOUT[1:0] outputs
7:6	-	-	Reserved
5	WO	0x0	Drives the PTMIDLEnACK output
4	WO	0x0	Drives the PTMDBGREQ output
3:0	WO	0x0	Reserved

PTM_ITMISCIN

Address: PTM_BASE + offset(0xee0)

Bits	Attr	Reset Value	Description
31:7	-	-	Reserved
6	RO	0x0	Returns the value of the STANDBYWFI input
5	-	-	Reserved
4	RO	0x0	Returns the value of the PTMDBGACK input
3:0	RO	0x0	Returns the value of the EXTIN[3:0] inputs

PTM_ITTRIGGER

Address: PTM_BASE + offset(0xee8)

Bits	Attr	Reset Value	Description
31:1	-	-	Reserved
0	WO	0x0	Drives the PTMTRIGGER output

PTM_ITATBDA0

Address: PTM_BASE + offset(0xeec)

Bits	Attr	Reset Value	Description
31:5	-	-	Reserved
4	WO	-	Drives the ATDATAM[31] output
3	WO	-	Drives the ATDATAM[23] output
2	WO	-	Drives the ATDATAM[15] output
1	WO	-	Drives the ATDATAM[7] output
0	WO	-	Drives the ATDATAM[0] output

PTM_ITATBCTR2

Address: PTM_BASE + offset(0xef0)

Bits	Attr	Reset Value	Description
31:2	-	-	Reserved
1	RO	-	Returns the value of the AFVALIDM input
0	RO	-	Returns the value of the ATREADYM input

PTM_ITATBID

Address: PTM_BASE + offset(0xef4)

Bits	Attr	Reset Value	Description
31:7	-	-	Reserved
6:0	WO	-	Drives the ATIDM[6:0] outputs

PTM_ITATBCTR0

Address: PTM_BASE + offset(0xef8)

Bits	Attr	Reset Value	Description
31:10	-	-	Reserved
9:8	WO	-	Drives the ATBYTESM outputs
7:2	-	-	Reserved
1	WO	-	Drives the AFREADYM output
0	WO	-	Drives the ATVALIDM output

PTM_ETMITCTRL

Address: PTM_BASE + offset(0xff0)

Bits	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x0	<p>When bit [0] is set to 1, the PTM enters an integration mode. On reset this bit is cleared to 0.</p> <p>Before entering integration mode, the PTM must be powered up and in programming mode. This means bit [0] of the Main Control Register is set to 0, and bit [10] of the Main Control Register is set to 1.</p> <p>After leaving integration mode, the PTM must be reset before attempting to perform tracing.</p>

PTM_PID4

Address: PTM_BASE + offset(0xfd0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x04	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

PTM_PID5

Address: PTM_BASE + offset(0xfd4)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

PTM_PID6

Address: PTM_BASE + offset(0xfd8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

PTM_PID7

Address: PTM_BASE + offset(0fdc)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.

3:0	-	-	Reserved
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PTM_PID0

Address: PTM_BASE + offset(0xfe0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x50	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

PTM_PID1

Address: PTM_BASE + offset(0xfe4)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0xb9	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

PTM_PID2

Address: PTM_BASE + offset(0xfe8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x1b	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

PTM_PID3

Address: PTM_BASE + offset(0xfc)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

PTM_CID0

Address: PTM_BASE + offset(0xff0)

Bits	Attr	Reset Value	Description
31:0	RO	0xd	The component identification registers identify the PTM as a CoreSight component

PTM_CID1

Address: PTM_BASE + offset(0xff4)

Bits	Attr	Reset Value	Description
31:0	RO	0x90	The component identification registers identify the PTM as a CoreSight component

PTM_CID2

Address: PTM_BASE + offset(0xff8)

Bits	Attr	Reset Value	Description
31:0	RO	0x05	The component identification registers identify the PTM as a CoreSight component

PTM_CID3

Address: PTM_BASE + offset(0ffc)

Bits	Attr	Reset Value	Description
31:0	RO	0xb1	The component identification registers identify the PTM as a CoreSight component

6.4.9 Funnel register summary

Name	Offset	Size	Reset Value	Description
FUNNEL_FCR	0x0	W	0x300	CSTF Control Register
FUNNEL_PCR	0x4	W	0xfac688	CSTF Priority Control Register
FUNNEL_ITATBDATA0	0xeeeC	W	0x0	CSTF Integration Test Registers
FUNNEL_ITATBCTR2	0xef0	W	0x0	CSTF Integration Test Registers
FUNNEL_ITATBCTR1	0xef4	W	0x0	CSTF Integration Test Registers
FUNNEL_ITATBCTR0	0xef8	W	0x0	CSTF Integration Test Registers
FUNNEL_IMCR	0xff0	W	0x0	Integration Mode Control Register
FUNNEL_CTSR	0xfa0	W	0xf	Claim Tag Set Register
FUNNEL_CTCR	0xfa4	W	0x0	Claim Tag Clear Register
FUNNEL_LA	0xfb0	W	-	Lock Access
FUNNEL_LS	0xfb4	W	0x0	Lock Status
FUNNEL_AS	0xfb8	W	0x0	Authentication status
FUNNEL_DI	0xfc8	W	0x28	Device ID
FUNNEL_DTI	0xfcC	W	0x12	Device Type Identifier
FUNNEL_PID4	0xfd0	W	0x04	Peripheral ID4
FUNNEL_PID0	0xfe0	W	0x08	Peripheral ID0
FUNNEL_PID1	0xfe4	W	0xb9	Peripheral ID1
FUNNEL_PID2	0xfe8	W	0x1b	Peripheral ID2
FUNNEL_PID3	0fec	W	0x00	Peripheral ID3
FUNNEL_CID0	0xff0	W	0xd	Component ID0
FUNNEL_CID1	0xff4	W	0x90	Component ID1
FUNNEL_CID2	0xff8	W	0x05	Component ID2
FUNNEL_CID3	0ffc	W	0xb1	Component ID3

6.4.10 Funnel register details

FUNNEL_CR

Address: FUNNEL_BASE + offset(0x000)

Bits	Attr	Reset Value	Description
31:12	-	-	Reserved
11:8	RW	0x3	<p>Minimum hold time[3:0]</p> <p>The formatting scheme can easily become inefficient if fast switching occurs, so, where possible, this must be minimized. If a source has nothing to transmit, then another source is selected irrespective of the minimum number of cycles. Reset is 0x3. The CSTF holds for the minimum hold time and one additional cycle.</p> <p>The maximum value that can be entered is 0xE and this equates to 15 cycles.</p> <p>0xF is reserved.</p>
7	RW	0x0	<p>Enable Slave port 7</p> <p>Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection scheme. The reset value is all clear, that is, all ports disabled.</p>
6	RW	0x0	<p>Enable Slave port 6</p> <p>Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection scheme. The reset value is all clear, that is, all ports disabled.</p>
5	RW	0x0	<p>Enable Slave port 5</p> <p>Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection scheme. The reset value is all clear, that is, all ports disabled.</p>
4	RW	0x0	<p>Enable Slave port 4</p> <p>Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection scheme. The reset value is all clear, that is, all ports disabled.</p>
3	RW	0x0	<p>Enable Slave port 3</p> <p>Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection scheme. The reset value is all clear, that is, all ports disabled.</p>
2	RW	0x0	<p>Enable Slave port 2</p> <p>Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection scheme. The reset value is all clear, that is, all ports disabled.</p>
1	RW	0x0	<p>Enable Slave port 1</p> <p>Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection</p>

			scheme. The reset value is all clear, that is, all ports disabled.
0	RW	0x0	Enable Slave port 0 Setting this bit enables this input, or slave, port. If the bit is not set then this has the effect of excluding the port from the priority selection scheme. The reset value is all clear, that is, all ports disabled.

FUNNEL_PCR

Address: FUNNEL_BASE + offset(0x004)

Bits	Attr	Reset Value	Description
31:24	-	-	Reserved
23:21	RW	0x0	PriPort 7 Priority value of the eighth port. The value written into this location is the value that you want to assign the eighth slave port.
20:18	RW	0x0	PriPort 6 7th port priority value.
17:15	RW	0x0	PriPort 5 6th port priority value.
14:12	RW	0x0	PriPort 4 5th port priority value.
11:9	RW	0x0	PriPort 3 4th port priority value.
8:6	RW	0x0	PriPort 2 3th port priority value.
5:3	RW	0x0	PriPort 1 2th port priority value.
2:0	RW	0x0	PriPort 0 Priority value of the first slave port. The value written into this location is the value that you want to assign the first slave port

FUNNEL_ITATBDATA0

Address: FUNNEL_BASE + offset(0xeeec)

Bits	Attr	Reset Value	Description
31:5	-	-	Reserved
4	RW	0x0	the value of ATDATAS<31>
3	RW	0x0	the value of ATDATAS<23>
2	RW	0x0	the value of ATDATAS<15>
1	RW	0x0	the value of ATDATAS<7>
0	RW	0x0	the value of ATDATAS<0>

FUNNEL_ITATBCTR2

Address: FUNNEL_BASE + offset(0xef0)

Bits	Attr	Reset Value	Description
31:2	-	-	Reserved
1	RW	0x0	the value of AFVALIDM
0	RW	0x0	the value of ATREADYM

FUNNEL_ITATBCTR1

Address: FUNNEL_BASE + offset(0xef4)

Bits	Attr	Reset Value	Description
31:7	-	-	Reserved
6:0	RW	0x0	the value of ATIDS

FUNNEL_ITATBCTR0

Address: FUNNEL_BASE + offset(0xef4)

Bits	Attr	Reset Value	Description
31:10	-	-	Reserved
9:8	RW	0x0	the value of ATBYTESS<n>
7:2	-	-	Reserved
1	RW	0x0	the value of AFREADYS<n>
0	RW	0x0	Read the value of ATVALIDS<n>

FUNNEL_CTS- FUNNEL_CTC

Address: FUNNEL_BASE + offset(0xfa0-0xfa4)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RW	0x0	The CSTF implements a four-bit claim tag. The use of bits [3:0] is software defined.

FUNNEL_LA- FUNNEL_LS

Address: FUNNEL_BASE + offset(0xfb0-0xfb4)

Bits	Attr	Reset Value	Description
31:3	-	-	Reserved
2:0	RW	0x3	The CSTF implements two memory maps controlled through PADDRDBG31. When PADDRDBG31 is HIGH, the Lock Status Register reads as 0x0 indicating that no lock exists. When PADDRDBG31 is LOW, the Lock Status Register reads as 0x3 from reset. This indicates a 32-bit lock access mechanism is present and is locked.

FUNNEL_AS

Address: FUNNEL_BASE + offset(0xfb8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	Reports the required security level. This is set to 0x00 for functionality not implemented.

FUNNEL_DID

Address: FUNNEL_BASE + offset(0xfc8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RW	0x0	The CSTF implements a static priority scheme.

3:0	RW	0x8	This is the value of the Verilog define PORTCOUNT and represents the number of input ports connected. By default all 8 ports are connected. 0x0 and 0x1 are illegal values.
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FUNNEL_DTI

Address: FUNNEL_BASE + offset(0xfc0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x12	A value of 0x12 identifies this device as a trace link (0x2) and specifically as a funnel/router (0x1)

FUNNEL_PID4

Address: FUNNEL_BASE + offset(0xfd0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x04	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_PID5

Address: FUNNEL_BASE + offset(0xfd4)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_PID6

Address: FUNNEL_BASE + offset(0xfd8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_PID7

Address: FUNNEL_BASE + offset(0fdc)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_PDO

Address: FUNNEL_BASE + offset(0xfe0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x50	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_PID1

Address: FUNNEL_BASE + offset(0xfe4)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0xb9	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_PID2

Address: FUNNEL_BASE + offset(0xfe8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x1b	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_PID3

Address: FUNNEL_BASE + offset(0xfec)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

FUNNEL_CID0

Address: FUNNEL_BASE + offset(0xff0)

Bits	Attr	Reset Value	Description
31:0	RO	0x0d	The component identification registers identify the PTM as a CoreSight component

FUNNEL_CID1

Address: FUNNEL_BASE + offset(0xff4)

Bits	Attr	Reset Value	Description
31:0	RO	0x90	The component identification registers identify the PTM as a CoreSight component

FUNNEL_CID2

Address: FUNNEL_BASE + offset(0xff8)

Bits	Attr	Reset Value	Description
31:0	RO	0x05	The component identification registers identify the PTM as a CoreSight component

FUNNEL_CID3

Address: FUNNEL_BASE + offset(0xffc)

Bits	Attr	Reset Value	Description
31:0	RO	0xb1	The component identification registers identify the PTM as a CoreSight component

6.4.11 CTI register summary

Name	Offset	Size	Reset Value	Description
CTI_CTICONTROL	0x000	W	0x0	CTI Control Register
CTI_CTIINTACK	0x010	W	-	CTI Interrupt Acknowledge Register
CTI_CTIAPPSET	0x014	W	0x0	CTI Application Trigger Set Register
CTI_CTIAPPCLEAR	0x018	W	0x0	CTI Application Trigger Clear Register
CTI_CTIAPPPULSE	0x01c	W	0x0	CTI Application Pulse Register
CTI_CTIINEN	0x020-0x03c	W	0x0	CTI Trigger to Channel Enable Registers, CTIINEN0-7
CTI_CTIOUTEN	0x0a0-0x0bc	W	0x0	CTI Channel to Trigger Enable Registers, CTIOUTEN0-7
CTI_CТИTRIGINSTATUS	0x130	W	0x0	CTI Trigger In Status Register, CTITRIGINSTATUS
CTI_CТИCHINSTATUS	0x138	W	-	CTI Channel In Status Register, CTICHINSTATUS
CTI_CТИCHOUTSTATUS	0x13c	W	0x0	CTI Channel Out Status Register
CTI_CТИGATE	0x140	W	0xf	Enable CTI Channel Gate Register
CTI_ASICCTL	0x144	W	0x0	External Multiplexor Control Register
CTI_ITCHINACK	0xedc	W	0x0	ITCHINACK Register
CTI_ITTRIGINACK	0xee0	W	0x0	ITTRIGINACK Register
CTI_ITCHOUT	0xee4	W	0x0	ITCHOUT Register
CTI_ITTRIGOUT	0xee8	W	0x0	ITTRIGOUT Register
CTI_ITCHOUTACK	0xec	W	0x0	ITCHOUTACK Register
CTI_ITTRIGOUTACK	0xef0	W	0x0	ITTRIGOUTACK Register
CTI_ITCHIN	0xef4	W	0x0	ITCHIN Register
CTI_ITTRIGIN	0xef8	W	0x0	ITTRIGIN Register
CTI_ITCTRL	0xf00	W	0x0	ITCTRL Register
CTI_CTSR	0xfa0	W	0xf	Claim Tag Set Register
CTI_CTCR	0xfa4	W	0x0	Claim Tag Clear Register

CTI_LA	0xfb0	W	-	Lock Access
CTI_LS	0xfb4	W	0x0	Lock Status
CTI_AS	0xfb8	W	0x0	Authentication status
CTI_DI	0xfc8	W	0x28	Device ID
CTI_DTI	0xfcC	W	0x12	Device Type Identifier
CTI_PID4	0xfd0	W	0x04	Peripheral ID4
CTI_PID5	0xfd4	W	0x00	Peripheral ID5
CTI_PID6	0xfd8	W	0x00	Peripheral ID6
CTI_PID7	0fdc	W	0x00	Peripheral ID7
CTI_PID0	0xfe0	W	0x08	Peripheral ID0
CTI_PID1	0xfe4	W	0xb9	Peripheral ID1
CTI_PID2	0xfe8	W	0x1b	Peripheral ID2
CTI_PID3	0fec	W	0x00	Peripheral ID3
CTI_CID0	0xff0	W	0xd	Component ID0
CTI_CID1	0xff4	W	0x90	Component ID1
CTI_CID2	0xff8	W	0x05	Component ID2
CTI_CID3	0ffc	W	0xb1	Component ID3

6.4.12 CTI register details

CTI_CTICONTROL

Address: CTI_BASE + offset(0x000)

Bits	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x0	GLBEN Enables or disables the ECT: 0 = disabled (reset) 1 = enabled. When disabled, all cross triggering mapping logic functionality is disabled for this processor

CTI_CTIINTACK

Address: CTI_BASE + offset(0x010)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	WO	-	INTACK Acknowledges the corresponding CTITRIGOUT output: 1 = CTITRIGOUT is acknowledged and is cleared when MAPTRIGOUT is LOW. 0 = no effect. There is one bit of the register for each CTITRIGOUT output

CTI_CTIAPPSET

Address: CTI_BASE + offset(0x014)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RW	0x0	APPSET Setting a bit HIGH generates a channel event for the selected channel.

			<p>Read: 0 = application trigger inactive (reset) 1 = application trigger active.</p> <p>Write: 0 = no effect 1 = generate channel event. There is one bit of the register for each channel</p>
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CTI_CTIAPPCLEAR

Address: CTI_BASE + offset(0x018)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	WO	-	<p>Clears corresponding bits in the CTIAPPSET register. 1 = application trigger disabled in the CTIAPPSET register 0 = no effect. There is one bit of the register for each channel.</p>

CTI_CTIAPPPULSE

Address: CTI_BASE + offset(0x01c)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	WO	-	<p>APPULSE Setting a bit HIGH generates a channel event pulse for the selected channel. Write: 1 = channel event pulse generated for one CTICLK period 0 = no effect. There is one bit of the register for each channel.</p>

CTI_CTIINENO-7

Address: CTI_BASE + offset(0x020-0x03c)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RW	0x0	<p>TRIGINEN Enables a cross trigger event to the corresponding channel when an CTITRIGIN is activated. 1 = enables the CTITRIGIN signal to generate an event on the respective channel of the CTM. There is one bit of the register for each of the four channels. For example in register CTIINENO, TRIGINEN[0] set to 1 enables CTITRIGIN onto channel 0. 0 = disables the CTITRIGIN signal from generating an event on the respective channel of the CTM</p>

CTI_CTIOUTENO-7

Address: CTI_BASE + offset(0x0a0-0x0bc)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RW	0x0	TRIGOUTEN Changing the value of this bit from a 0 to a 1 enables a channel event for the corresponding channel to generate an CTITRIGOUT output: 0 = the channel input (CTICHIN) from the CTM is not routed to the CTITRIGOUT output 1 = the channel input (CTICHIN) from the CTM is routed to the CTITRIGOUT output. There is one bit for each of the four channels. For example in register CTIOUTEN0, enabling bit 0 enables CTICHIN[0] to cause a trigger event on the CTITRIGOUT[0] output.

CTI_CTI TRIGIN STATUS

Address: CTI_BASE + offset(0x130)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	TRIGINSTATUS Shows the status of the CTITRIGIN inputs: 1 = CTITRIGIN is active 0 = CTITRIGIN is inactive. Because the register provides a view of the raw CTITRIGIN inputs, the reset value is unknown. There is one bit of the register for each trigger input.

CTI_CTI TRIGOUT STATUS

Address: CTI_BASE + offset(0x134)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	TRIGOUTSTATUS Shows the status of the CTITRIGOUT outputs. 1 = CTITRIGOUT is active 0 = CTITRIGOUT is inactive (reset). There is one bit of the register for each trigger output.

CTI_CTI CHIN STATUS

Address: CTI_BASE + offset(0x138)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RW	0x0	CTICHINSTATUS Shows the status of the CTICHIN inputs: 1 = CTICHIN is active 0 = CTICHIN is inactive. Because the register provides a view of the raw CTICHIN inputs from the CTM, the reset value is unknown. There is one bit of the register for each channel input.

CTI_CTICHOUTSTATUS

Address: CTI_BASE + offset(0x13c)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RW	0x0	CTICHOUTSTATUS Shows the status of the CTICHOUT outputs. 1 = CTICHOUT is active 0 = CTICHOUT is inactive (reset). There is one bit of the register for each channel output.

CTI_CTIGATE

Address: CTI_BASE + offset(0x140)

Bits	Attr	Reset Value	description
31:4	-	-	Reserved
3	RW	0x0	CTIGATEEN3 Enable CTICHOUT3. Set to 0 to disable channel propagation.
2	RW	0x0	CTIGATEEN2 Enable CTICHOUT2. Set to 0 to disable channel propagation.
1	RW	0x0	CTIGATEEN1 Enable CTICHOUT1. Set to 0 to disable channel propagation.
0	RW	0x0	CTIGATEENO Enable CTICHOUT0. Set to 0 to disable channel propagation

CTI_ASICCTL

Address: CTI_BASE + offset(0x144)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	ASICCTL Implementation-defined ASIC control, value written to the register is output on ASICCTL[7:0]. If external multiplexing of trigger signals is implemented then the number of multiplexed signals on each trigger must be reflected within the Device ID Register. This is done within a Verilog define EXTMUXNUM.

CTI_ITCHINACK

Address: CTI_BASE + offset(0xedc)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	WO	-	CTCHINACK Set the value of the CTCHINACK outputs

CTI_ITTRIGINACK

Address: CTI_BASE + offset(0xee0)

Bits	Attr	Reset Value	Description
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31:8	-	-	Reserved
7:0	WO	-	CTTRIGINACK Set the value of the CTTRIGINACK outputs

CTI_ITCHOUT

Address: CTI_BASE + offset(0xee4)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	WO	-	CTCHOUT Set the value of the CTCHOUT outputs

CTI_ITTRIGOUT

Address: CTI_BASE + offset(0xee8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	WO	-	CTTRIGOUT Set the value of the CTTRIGOUT outputs

CTI_ITCHOUTACK

Address: CTI_BASE + offset(0xeeC)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RO	0x0	CTCHOUTACK Read the values of the CTCHOUTACK inputs

CTI_ITTRIGOUTACK

Address: CTI_BASE + offset(0xef0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RO	0x0	CTTRIGOUTACK Read the values of the CTTRIGOUTACK inputs

CTI_ITCHIN

Address: CTI_BASE + offset(0xef4)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RO	0x0	CTCHIN Read the values of the CTCHIN inputs

CTI_ITTRIGIN

Address: CTI_BASE + offset(0xef8)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RO	0x0	CTTRIGIN Read the values of the CTTRIGIN inputs

CTI_CTS- CTI_CTC

Address: CTI_BASE + offset(0xfa0-0xfa4)

Bits	Attr	Reset Value	Description

31:4	-	-	Reserved
3:0	RW	0x0	The CTI implements a four-bit claim tag. The use of bits [3:0] is software defined

CTI_LA- CTI_LS

Address: CTI_BASE + offset(0xfb0-0xfb4)

Bits	Attr	Reset Value	Description
31:3	-	-	Reserved
2:0	RW	0x3	The CTI implements two memory maps controlled through PADDRDBG31. When PADDRDBG31 is HIGH, the Lock Status Register reads as 0x0 indicating that no lock exists. When PADDRDBG31 is LOW, the Lock Status Register reads as 0x3 from reset. This indicates a 32-bit lock access mechanism is present and is locked.

CTI_AS

Address: CTI_BASE + offset(0xfb8)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3	RW	0x0	Current value of noninvasive debug enable signals
2	RW	0x0	Non-invasive debug controlled
1	RW	0x0	Current value of invasive debug enable signals
0	RW	0x0	Invasive debug controlled

CTI_DID

Address: CTI_BASE + offset(0xfc8)

Bits	Attr	Reset Value	Description
31:20	-	-	Reserved
19:16	RO	0x0	Number of ECT channels available.
15:8	RO	0x0	Number of ECT triggers available.
7:5	-	-	Reserved
4:0	RO	0x0	Indicates the number of multiplexing available on Trigger Inputs and Trigger Outputs using ASICCTL. Default value of 5'b00000 indicating no multiplexing present. Reflects the value of the Verilog `define EXTMUXNUM that you must alter accordingly.

CTI_DTID

Address: CTI_BASE + offset(0xfc0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x14	0x14 indicates this device has a major type of debug control logic component (0x4) and sub-type corresponding to cross trigger (0x1).

CTI_PID4

Address: CTI_BASE + offset(0xfd0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
3:0	RO	0x3	The CTI is identified as an ARM component with a JEP106 identity at 0x3B and a JEP106 continuation code at 0x4 (fifth bank).

CTI_PID0

Address: CTI_BASE + offset(0xfe0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x0	Middle BCD value of Device number.
3:0	RO	0x6	Lower BCD value of Device number.

CTI_PID1

Address: CTI_BASE + offset(0xfe4)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0xb	The CTI is identified as an ARM component with a JEP106 identity at 0x3B and a JEP106 continuation code at 0x4 (fifth bank).
3:0	RO	0x9	Upper BCD value of Device number.

CTI_PID2

Address: CTI_BASE + offset(0xfe8)

Bits	Attr	Reset Value	Description
31:3	-	-	Reserved
2:0	RO	0x4	The CTI is identified as an ARM component with a JEP106 identity at 0x3B and a JEP106 continuation code at 0x4 (fifth bank).
3:0	-	-	Reserved

CTI_PID3

Address: CTI_BASE + offset(0fec)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

CTI_CID0

Address: CTI_BASE + offset(0xff0)

Bits	Attr	Reset Value	Description
31:0	RO	0x0d	The component identification registers identify the PTM as a CoreSight component

CTI_CID1

Address: CTI_BASE + offset(0xff4)

Bits	Attr	Reset Value	Description
31:0	RO	0x90	The component identification registers identify the PTM as a CoreSight component

CTI_CID2

Address: CTI_BASE + offset(0xff8)

Bits	Attr	Reset Value	Description
31:0	RO	0x05	The component identification registers identify the PTM as a CoreSight component

CTI_CID3

Address: CTI_BASE + offset(0ffc)

Bits	Attr	Reset Value	Description
31:0	RO	0xb1	The component identification registers identify the PTM as a CoreSight component

6.4.13 TPIU register summary

Name	Offset	Size	Reset Value	Description
TPIU_SPSR	0x000	W	0x00000008a	Supported port size
TPIU_CPSR	0x004	W	0x000000001	Current port size
TPIU_STMR	0x100	W	0x11f	Supported trigger modes
TPIU_TCR	0x104	W	0x00	Trigger counter value
TPIU_TMR	0x108	W	0x00	Trigger multiplier
TPIU_STPMR	0x200	W	0x3000f	Supported test pattern/modes
TPIU_CTPMR	0x204	W	0x00000	Current test pattern/mode
TPIU_TTPRCR	0x208	W	0x00	TPIU Test pattern repeat counter
TPIU_FFSR	0x300	W	0x00000006	Formatter and flush status
TPIU_FFCR	0x304	W	0x00000100	Formatter and flush control
TPIU_FSCR	0x308	W	0x000000000	Formatter synchronization counter
TPIU_EXCTLPRIN	0x400	W	N/A	EXTCTL In Port
TPIU_EXCTLPROUT	0x404	W	0x00	EXTCTL Out Port
TPIU_ITTRFLINACK	0xee4	W	N/A	Integration Register
TPIU_ITTRFLIN	0xee8	W	N/A	Integration Register
TPIU_ITATBDA	0xec	W	N/A	Integration Register
TPIU_ITATBCTR2	0xef0	W	N/A	Integration Register
TPIU_ITATBCTR0	0xef8	W	N/A	Integration Register
TPIU_ITAMCTL	0xf00	W	0x000000000	Integration Mode control register
TPIU_CTS	0xfa0	W	0x00000000f	Claim tag set
TPIU_CTC	0xfa4	W	0x000000000	Claim tag clear

TPIU_LA	0xfb0	W	N/A	Lock access
TPIU_LS	0xfb4	W	N/A	Local status
TPIU_AS	0xfb8	W	0x00000000	Authentication status
TPIU_DID	0xfc8	W	0x00000000	Device ID
TPIU_DTID	0xfcfc	W	0x00000011	Device type identifier
TPIU_PID4	0xfd0	W	0x00000004	Peripheral ID4
TPIU_PID0	0xfe0	W	0x00000041	Peripheral ID0
TPIU_PID1	0xfe4	W	0x000000b9	Peripheral ID1
TPIU_PID2	0xfe8	W	0x0000000b	Peripheral ID2
TPIU_PID3	0xfec	W	0x00000000	Peripheral ID3
TPIU_CID0	0xff0	W	0x0000000d	Component ID0
TPIU_CID1	0xff4	W	0x00000090	Component ID1

6.4.14 TPIU detailed register description

TPIU_SPSR

Address: TPIU_BASE + offset(0x000)

Bits	Attr	Reset Value	Description
31:0	RW	0x0000008a	<p>This register is read/write. Each bit location represents a single port size that is supported on the device, that is, 32-1 in bit locations [31:0]. If the bit is set then that port size is allowed. By default the RTL is designed to support all port sizes, set to 0xFFFFFFFF. This register reflects the value of the CSTPIU_SUPPORTSIZE_VAL Verilog `define value, currently not user modifiable, and is further constrained by the input tie-off TPMAXDATASIZE.</p> <p>The external tie-off, TPMAXDATASIZE, must be set during finalization of the ASIC to reflect the actual number of TRACEDATA signals being wired to physical pins. This is to ensure that tools do not attempt to select a port width that cannot be captured by an attached TPA. The value on TPMAXDATASIZE causes bits within the Supported Port Size register that represent wider widths to be clear, that is, unsupported</p>

TPIU_CPSR

Address: TPIU_BASE + offset(0x004)

Bits	Attr	Reset Value	Description
31:0	RW	0x00000001	<p>This register is read/write. The Current Port Size Register has the same format as the Supported Port Sizes register but only one bit is set, and all others must be zero. Writing values with more than one bit set or setting a bit that is not indicated as supported is not supported and causes unpredictable behavior.</p> <p>On reset this defaults to the smallest possible port size, 1 bit, and so reads as 0x00000001</p>

TPIU_STMR

Address: TPIU_BASE + offset(0x100)

Bits	Attr	Reset Value	Description
31:18	-	-	Reserved
17	RO	0x0	Trigger Counter running. A trigger has occurred but the counter is not at zero.
16	RO	0x1	Triggered. A trigger has occurred and the counter has reached zero
15:9	-	-	Reserved
8	RO	0x0	8-bit wide counter register implemented.
7:5	-	-	Reserved
4	RO	0x1	Multiply the Trigger Counter by 65536 supported.
3	RO	0x1	Multiply the Trigger Counter by 256 supported.
2	RO	0x1	Multiply the Trigger Counter by 16 supported.
1	RO	0x1	Multiply the Trigger Counter by 4 supported
0	RO	0x1	Multiply the Trigger Counter by 2 supported

TPIU_TCR

Address: TPIU_BASE + offset(0x104)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	8-bit counter value for the number of words to be output from the formatter before a trigger is inserted. Reset value is 0x00.

TPIU_TMR

Address: TPIU_BASE + offset(0x108)

Bits	Attr	Reset Value	Description
31:5	-	-	Reserved
4	RO	0x0	Multiply the Trigger Counter by 65536 supported.
3	RO	0x0	Multiply the Trigger Counter by 256 supported.
2	RO	0x0	Multiply the Trigger Counter by 16 supported.
1	RO	0x0	Multiply the Trigger Counter by 4 supported
0	RO	0x0	Multiply the Trigger Counter by 2 supported

TPIU_STPMR

Address: TPIU_BASE + offset(0x200)

Bits	Attr	Reset Value	Description
31:18	-	-	Reserved
17	RO	0x1	Continuous mode
16	RO	0x1	Timed mode
15:4	-	-	Reserved
3	RO	0x1	FF/00 Pattern

2	RO	0x1	AA/55 Pattern
1	RO	0x1	Walking 0s Pattern
0	RO	0x1	Walking 1s Pattern

TPIU_CTPMR

Address: TPIU_BASE + offset(0x204)

Bits	Attr	Reset Value	Description
31:18	-	-	Reserved
17:16	RW	0x0	Mode select
15:4	-	-	Reserved
3:0	RW	0x0	Number of cycles

TPIU_TTPRCR

Address: TPIU_BASE + offset(0x208)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	8-bit counter value to indicate the number of TRACECLKIN cycles that a pattern runs for before switching to the next pattern. Default value is 0

TPIU_FFSR

Address: TPIU_BASE + offset(0x300)

Bits	Attr	Reset Value	Description
31:3	-	-	Reserved
2	RO	0x1	If this bit is set then TRACECTL is present. If no TRACECTL pin is available, that is, this bit is zero, then the data formatter must be used and only in continuous mode. This is constrained by the CSTPIU_TRACECTL_VAL Verilog `define, which is not user modifiable, and the external tie-off TPCTL. If either constraint reports zero/LOW then no TRACECTL is present and this inability to use the pin is reflected in this register.
1	RO	0x1	Formatter stopped. The formatter has received a stop request signal and all trace data and post-amble has been output. Any more trace data on the ATB interface is ignored and ATREADYS goes HIGH.
0	RO	0x0	Flush In Progress. This is an indication of the current state of AFVALIDS

TPIU_FFCR

Address: TPIU_BASE + offset(0x304)

Bits	Attr	Reset Value	Description
31:14	-	-	Reserved
13	RW	0x0	Stop the formatter after a Trigger Event is observed. Reset to disabled, or zero.

12	RW	0x0	Stop the formatter after a flush completes (return of AFREADYS). This forces the FIFO to drain off any part-completed packets. Setting this bit enables this function but this is clear on reset, or disabled.
11	-	-	Reserved
10	RW	0x0	Indicates a trigger on Flush completion on AFREADYS being returned.
9	RW	0x0	Indicate a trigger on a Trigger Event
8	RW	0x1	Indicate a trigger on TRIGIN being asserted.
7	-	-	Reserved
6	RW	0x0	Manually generate a flush of the system. Setting this bit causes a flush to be generated. This is cleared when this flush has been serviced. This bit is clear on reset.
5	RW	0x0	Generate flush using Trigger event. Set this bit to cause a flush of data in the system when a Trigger Event occurs. Reset value is this bit clear.
4	RW	0x0	Generate flush using the FLUSHIN interface. Set this bit to enable use of the FLUSHIN connection. This is clear on reset.
3:2	-	-	Reserved
1	RW	0x0	Continuous Formatting, no TRACECTL. Embed in trigger packets and indicate null cycles using Sync packets. Reset value is this bit clear. Can only be changed when FtStopped is HIGH.
0	RW	0x0	Enable Formatting. Do not embed Triggers into the formatted stream. Trace disable cycles and triggers are indicated by TRACECTL, where fitted. Reset value is this bit clear. Can only be changed when FtStopped is HIGH.

TPIU_FSCR

Address: TPIU_BASE + offset(0x308)

Bits	Attr	Reset Value	Description
31:12	-	-	Reserved
11:0	RW	0x0	12-bit counter value to indicate the number of complete frames between full synchronization packets. Default value is 64 (0x40).

TPIU_ITTRFLINACK

Address: TPIU_BASE + offset(0xee4)

Bits	Attr	Reset Value	Description
31:2	-	-	Reserved
1	WO	-	Set the value of FLUSHINACK
0	WO	-	Set the value of TRIGINACK

TPIU_ITTRFLIN

Address: TPIU_BASE + offset(0xee8)

Bits	Attr	Reset Value	Description
31:2	-	-	Reserved
1	RO	0x0	Read the value of FLUSHIN
0	RO	0x0	Read the value of TRIGIN

TPIU_ITATBDATA0

Address: TPIU_BASE + offset(0xeec)

Bits	Attr	Reset Value	Description
31:5	-	-	Reserved
4	RO	0x0	Read the value of ATDATAS[31]
3	RO	0x0	Read the value of ATDATAS[23]
2	RO	0x0	Read the value of ATDATAS[15]
1	RO	0x0	Read the value of ATDATAS[7]
0	RO	0x0	Read the value of ATDATAS[0]

TPIU_ITATBCTR2

Address: TPIU_BASE + offset(0xef0)

Bits	Attr	Reset Value	Description
31:2	-	-	Reserved
1	WO	0x0	Set the value of AFVALIDS
0	WO	0x0	Set the value of ATREADYS

TPIU_ITATBCTR1

Address: TPIU_BASE + offset(0xef4)

Bits	Attr	Reset Value	Description
31:7	-	-	Reserved
6:0	RO	0x0	Read the value of ATIDS

TPIU_ITATBCTR0

Address: TPIU_BASE + offset(0xef8)

Bits	Attr	Reset Value	Description
31:10	-	-	Reserved
9:8	RO	0x0	Read the value of ATBYTESS
7:2	-	-	Reserved
1	RO	0x0	Read the value of AFREADYS
0	RO	0x0	Read the value of ATVALIDS

TPIU_CTS-TPIU_CTC

Address: TPIU_BASE + offset(0xfa0-0xfa4)

Bits	Attr	Reset Value	Description
31:4	-	-	Reserved
3:0	RW	0x0	The TPIU implements a four-bit claim tag. The use of bits [3:0] is software defined

TPIU_LA-TPIU_LS

Address: TPIU_BASE + offset(0xfb0-0xfb4)

Bits	Attr	Reset Value	Description
31:3	-	0xb1	Reserved
2:0	RW	0x3	The TPIU implements two memory maps controlled through PADDRDBG31. When PADDRDBG31 is HIGH, the Lock Status Register reads as 0x0 indicating that no lock exists. When PADDRDBG31 is LOW, the Lock Status Register reads as 0x3 from reset. This indicates a 32-bit lock access mechanism is present and is locked.

TPIU_AS

Address: TPIU_BASE + offset(0xfb8)

Bits	Attr	Reset Value	Description
31:0	RO	0x0	Reports the required security level. The TPIU has a default value of 0x00 to indicate that this functionality is not implemented.

TPIU_DID

Address: TPIU_BASE + offset(0xfc8)

Bits	Attr	Reset Value	Description
31:12	-	-	Reserved
11	RO	0x0	Indicates Serial Wire Output (UART/NRZ) is not supported.
10	RO	0x0	Indicates Serial Wire Output (Manchester) is not supported.
9	RO	0x0	Indicates trace clock + data is supported.
8:6	RO	0x0	FIFO size in powers of 2. A value of 2 gives a FIFO size of 4 entries, 16 bytes.
5	RO	0x0	Indicates the relationship between ATCLK and TRACECLKIN. 0x1 indicates asynchronous.
4:0	RO	0x0	Hidden Level of Input multiplexing. When nonzero this value indicates the type/number of ATB multiplexing present on the input to the ATB. Currently only 0x00 is supported, that is, no multiplexing present. This value is used to assist topology detection of the ATB structure

TPIU_DTID

Address: TPIU_BASE + offset(0xfc0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x11	0x11 indicates this device is a trace sink (0x1) and specifically a TPIU (0x1).

TPIU_PID4

Address: TPIU_BASE + offset(0xfd0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved

3:0	RO	0x3	The TPIU is identified as an ARM component with a JEP106 identity at 0x3B and a JEP106 continuation code at 0x4 (fifth bank).
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TPIU_PID0

Address: TPIU_BASE + offset(0xfe0)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x1	Middle BCD value of Device number.
3:0	RO	0x2	Lower BCD value of Device number.

TPIU_PID1

Address: TPIU_BASE + offset(0xfe4)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0xb	The TPIU is identified as an ARM component with a JEP106 identity at 0x3B and a JEP106 continuation code at 0x4 (fifth bank).
3:0	RO	0x9	Upper BCD value of Device number.

TPIU_PID2

Address: TPIU_BASE + offset(0xfe8)

Bits	Attr	Reset Value	Description
31:3	-	-	Reserved
2:0	RO	0x4	The TPIU is identified as an ARM component with a JEP106 identity at 0x3B and a JEP106 continuation code at 0x4 (fifth bank).
3:0	-	-	Reserved

TPIU_PID3

Address: TPIU_BASE + offset(0xfec)

Bits	Attr	Reset Value	Description
31:8	-	-	Reserved
7:4	RO	0x00	The peripheral identification registers provide standard information required for all CoreSight components.
3:0	-	-	Reserved

TPIU_CID1

Address: TPIU_BASE + offset(0xff4)

Bits	Attr	Reset Value	Description
31:8	RO	0x0	Reserved
7:4	RO	0x9	The TPIU complies to the CoreSight class of components and this value is set to 0x9.
3:0	-	0x0	Reserved

Notes: Attr: **RW**- Read/writable, **RO**- read only, **WO**- write only, **RWTC**-Readable and write "1" to clear the asserted bit from "1" to "0".

6.5 Interface description

6.5.1 DAP SWJ-DP interface

The following figure is the DAP SWJ-DP interface, the SWJ-DP is a combined JTAG-DP and SW-DP that enable you connect either a Serial Write Debug(SWJ) to JTAG probe to a target.

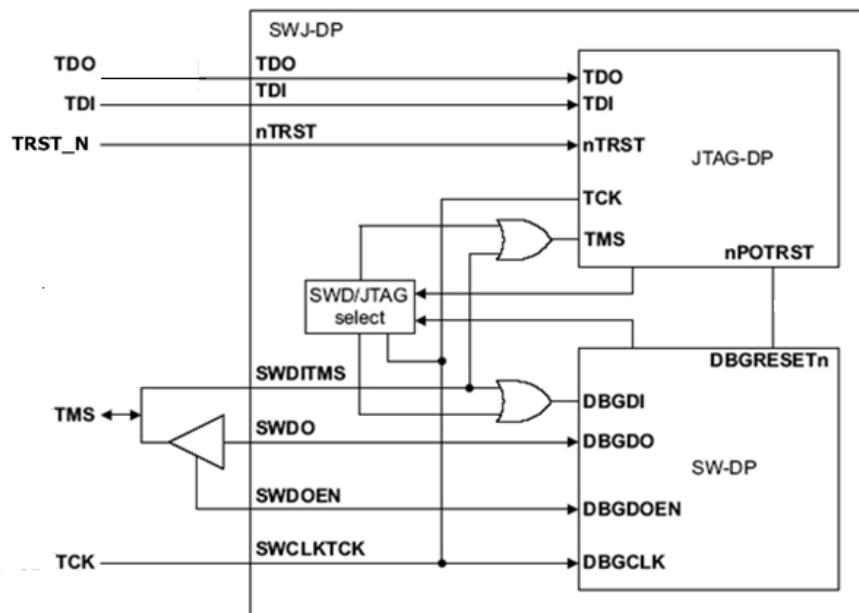


Fig. 6- 2 DAP SWJ interface

Table 6-1 SWJ interface

Module Pin	Direction	PAD Name	IOMUX Setting
TRST_N	I	TRST_N	Dedicated IO
TCK	I	TCK	Dedicated IO
TDI	I	TDI	Dedicated IO
TMS	IO	TMS	Dedicated IO
TDO	O	TDO	Dedicated IO

6.5.2 TPIU trace port interface

Table 6- 2 TPIU interface

Module Pin	Direction	PAD Name	IOMUX Setting
trace_data[0]	O	GPIO4_C[0]	GRF_GPIO4C_IOMUX[1:0]=0x2
trace_data[1]	O	GPIO4_C[1]	GRF_GPIO4C_IOMUX[3:2]=0x2
trace_data[2]	O	GPIO4_C[2]	GRF_GPIO4C_IOMUX[5:4]=0x2
trace_data[3]	O	GPIO4_C[3]	GRF_GPIO4C_IOMUX[7:6]=0x2
trace_data[4]	O	GPIO4_C[4]	GRF_GPIO4C_IOMUX[9:8]=0x2
trace_data[5]	O	GPIO4_C[5]	GRF_GPIO4C_IOMUX[11:10]=0x2
trace_data[6]	O	GPIO4_C[6]	GRF_GPIO4C_IOMUX[13:12]=0x2
trace_data[7]	O	GPIO4_C[7]	GRF_GPIO4C_IOMUX[15:14]=0x2

trace_data[8]	O	GPIO4_D[0]	GRF_GPIO4D_IOMUX[1:0]=0x2
trace_data[9]	O	GPIO4_D[1]	GRF_GPIO4D_IOMUX[3:2]=0x2
trace_data[10]	O	GPIO4_D[2]	GRF_GPIO4D_IOMUX[5:4]=0x2
trace_data[11]	O	GPIO4_D[3]	GRF_GPIO4D_IOMUX[7:6]=0x2
trace_data[12]	O	GPIO4_D[4]	GRF_GPIO4D_IOMUX[9:8]=0x2
trace_data[13]	O	GPIO4_D[5]	GRF_GPIO4D_IOMUX[11:10]=0x2
trace_data[14]	O	GPIO6_D[6]	GRF_GPIO4D_IOMUX[13:12]=0x2
trace_data[15]	O	GPIO6_D[7]	GRF_GPIO4D_IOMUX[15:14]=0x2
trace_clk	O	GPIO0_C[6]	GRF_GPIO0C_IOMUX[13:12]=0x1
trace_ctl	O	GPIO0_C[7]	GRF_GPIO0C_IOMUX[15:14]=0x1

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Chapter 7 GRF (General Register Files)

7.1 Overview

The general register file will be used to do static set by software, which is composed of many registers for system control.

7.2 Function Description

The function of general register file is :

- ◆ IOMUX control
- ◆ Control the state of gpio in power-down mode
- ◆ GPIO PAD pulldown and pullup control
- ◆ Used for common system control
- ◆ Used to record the system state

7.3 Register description

7.3.1 System Registe

Name	Offset	Size	Reset Value	Description
GRF_GPIO0L_DIR	0x0000	W	0x00000000	GPIO0A / GPIO0B output enable control
GRF_GPIO0H_DIR	0x0004	W	0x00000000	GPIO0C / GPIO0D output enable control
GRF_GPIO1L_DIR	0x0008	W	0x00000000	GPIO1A / GPIO0B output enable control
GRF_GPIO1H_DIR	0x000c	W	0x00000000	GPIO1C / GPIO1D output enable control
GRF_GPIO2L_DIR	0x0010	W	0x00000000	GPIO2A / GPIO2B output enable control
GRF_GPIO2H_DIR	0x0014	W	0x00000000	GPIO2C / GPIO2D output enable control
GRF_GPIO3L_DIR	0x0018	W	0x00000000	GPIO3A / GPIO3B output enable control
GRF_GPIO3H_DIR	0x001c	W	0x00000000	GPIO3C / GPIO3D output enable control
GRF_GPIO0L_DO	0x0020	W	0x00000000	GPIO0A / GPIO0B output control
GRF_GPIO0H_DO	0x0024	W	0x00000000	GPIO0C / GPIO0D output control
GRF_GPIO1L_DO	0x0028	W	0x00000000	GPIO1A / GPIO1B output control
GRF_GPIO1H_DO	0x002c	W	0x00000000	GPIO1C / GPIO1D output control
GRF_GPIO2L_DO	0x0030	W	0x00000000	GPIO2A / GPIO2B output control
GRF_GPIO2H_DO	0x0034	W	0x00000000	GPIO2C / GPIO2D output control
GRF_GPIO3L_DO	0x0038	W	0x00000000	GPIO3A / GPIO3B output control
GRF_GPIO3H_DO	0x003c	W	0x00000000	GPIO3C / GPIO3D output control
GRF_GPIO0L_EN	0x0040	W	0x00000000	GPIO0A / GPIO0B output enable
GRF_GPIO0H_EN	0x0044	W	0x00000000	GPIO0C / GPIO0D output enable

Name	Offset	Size	Reset Value	Description
GRF_GPIO1L_EN	0x0048	W	0x00000000	GPIO1A / GPIO1B output enable
GRF_GPIO1H_EN	0x004c	W	0x00000000	GPIO1C / GPIO1D output enable
GRF_GPIO2L_EN	0x0050	W	0x00000000	GPIO2A / GPIO2B output enable
GRF_GPIO2H_EN	0x0054	W	0x00000000	GPIO2C / GPIO2D output enable
GRF_GPIO3L_EN	0x0058	W	0x00000000	GPIO3A / GPIO3B output enable
GRF_GPIO3H_EN	0x005c	W	0x00000000	GPIO3C / GPIO3D output enable
GRF_GPIO0A_IOMUX	0x0060	W	0x00000000	GPIO0A iomux control
GRF_GPIO0B_IOMUX	0x0064	W	0x00000000	GPIO0B iomux control
GRF_GPIO0C_IOMUX	0x0068	W	0x00000000	GPIO0C iomux control
GRF_GPIO0D_IOMUX	0x006c	W	0x00000000	GPIO0D iomux control
GRF_GPIO1A_IOMUX	0x0070	W	0x00000000	GPIO1A iomux control
GRF_GPIO1B_IOMUX	0x0074	W	0x00000000	GPIO1B iomux control
GRF_GPIO1C_IOMUX	0x0078	W	0x00000000	GPIO1C iomux control
GRF_GPIO1D_IOMUX	0x007c	W	0x00000000	GPIO1D iomux control
GRF_GPIO2A_IOMUX	0x0080	W	0x00000000	GPIO2A iomux control
GRF_GPIO2B_IOMUX	0x0084	W	0x00000000	GPIO2B iomux control
GRF_GPIO2C_IOMUX	0x0088	W	0x00000000	GPIO2C iomux control
GRF_GPIO2D_IOMUX	0x008c	W	0x00000000	GPIO2D iomux control
GRF_GPIO3A_IOMUX	0x0090	W	0x00000000	GPIO3A iomux control
GRF_GPIO3B_IOMUX	0x0094	W	0x00000000	GPIO3B iomux control
GRF_GPIO3C_IOMUX	0x0098	W	0x00000000	GPIO3C iomux control
GRF_GPIO3D_IOMUX	0x009c	W	0x00000000	GPIO3D iomux control
GRF_SOC_CON0	0x00a0	W	0x0000000a	soc control register
GRF_SOC_CON1	0x00a4	W	0x00000006	soc control register
GRF_SOC_CON2	0x00a8	W	0x00000000	soc control register
GRF_SOC_STATUS0	0x00ac	W	0x002061e0	soc status register
GRF_DMAC0_CON0	0x00b0	W	0x00000002	DMAC0 control register
GRF_DMAC0_CON1	0x00b4	W	0x00000000	DMAC1 control register
GRF_DMAC0_CON2	0x00b8	W	0x00000000	DMAC0 control register
GRF_DMAC1_CON0	0x00bc	W	0x0000ffff	DMAC1 control register
GRF_DMAC1_CON1	0x00c0	W	0x00003fff	DMAC1 control register
GRF_DMAC1_CON2	0x00c4	W	0x0000000f	DMAC1 control register
GRF_DMAC1_CON3	0x00c8	W	0x00003fff	DMAC1 control register
GRF_CPU_CON0	0x00cc	W	0x00008407	cpu core sub-system configuration control

Name	Offset	Size	Reset Value	Description
GRF_CPU_CON1	0x00d0	W	0x00000000	cpu core sub-system configuration control
GRF_CPU_CON2	0x00d4	W	0x00004000	cpu core sub-system configuration control
GRF_CPU_CON3	0x00d8	W	0x00000000	cpu core sub-system configuration control
GRF_CPU_CON4	0x00dc	W	0x00000600	cpu core sub-system configuration control
GRF_CPU_CON5	0x00e0	W	0x00000e00	cpu core sub-system configuration control
GRF_DDRC_CON0	0x00ec	W	0x00000000	DDRC control register
GRF_DDRC_STAT	0x00f0	W	0x00000000	DDRC status
GRF_IO_CON0	0x00f4	W	0x00000018	IO drive strength configuration
GRF_IO_CON1	0x00f8	W	0x0000c001	IO drive strength configuration
GRF_IO_CON2	0x00fc	W	0x00001016	IO drive strength configuration
GRF_IO_CON3	0x0100	W	0x0000c241	IO drive strength configuration
GRF_IO_CON4	0x0104	W	0x00000012	IO drive strength configuration
GRF_SOC_STATUS1	0x0108	W	0x00000000	soc status register
GRF_UOC0_CON0	0x010c	W	0x0000c863	otg control register
GRF_UOC0_CON1	0x0110	W	0x000016fb	otg control register
GRF_UOC0_CON2	0x0114	W	0x00000000	otg control register
GRF_UOC0_CON3	0x0118	W	0x00000000	otg control register
GRF_UOC1_CON0	0x011c	W	0x0000c863	usb host control register
GRF_UOC1_CON1	0x0120	W	0x000016fb	usb host control register
GRF_UOC1_CON2	0x0124	W	0x00000000	otg control register
GRF_UOC1_CON3	0x0128	W	0x00000000	usb host control register
GRF_OS_REG0	0x0144	W	0x00000000	OS register
GRF_OS_REG1	0x0148	W	0x00000000	OS register
GRF_OS_REG2	0x014c	W	0x00000000	OS register
GRF_OS_REG3	0x0150	W	0x00000000	OS register
GRF_OS_REG4	0x0154	W	0x00000000	OS register
GRF_OS_REG5	0x0158	W	0x00000000	OS register
GRF_OS_REG6	0x015c	W	0x00000000	OS register
GRF_OS_REG7	0x0160	W	0x00000000	OS register

Notes:Size:**B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

7.3.2 Detail Register Description

GRF_GPIO0L_DIR

Address: Operational Base + offset (0x0000)

GPIO0A / GPIO0B output enable control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio0b_dir</p> <p>GPIO0B output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>
7:0	RW	0x00	<p>gpio0a_dir</p> <p>GPIO0A output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>

GRF_GPIO0H_DIR

Address: Operational Base + offset (0x0004)

GPIO0C / GPIO0D output enable control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio0d_dir</p> <p>GPIO0D output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>
7:0	RW	0x00	<p>gpio0c_dir</p> <p>GPIO0C output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>

GRF_GPIO1L_DIR

Address: Operational Base + offset (0x0008)

GPIO1A / GPIO0B output enable control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio1b_dir</p> <p>GPIO1B output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default)</p> <p>1:Output</p>
7:0	RW	0x00	<p>gpio1a_dir</p> <p>GPIO1A output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default)</p> <p>1:Output</p>

GRF_GPIO1H_DIR

Address: Operational Base + offset (0x000c)

GPIO1C / GPIO1D output enable control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio1d_dir GPIO1D output enable control When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits . 0: Input (default) 1:Output</p>
7:0	RW	0x00	<p>gpio1c_dir GPIO1C output enable control When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits . 0: Input (default) 1:Output</p>

GRF_GPIO2L_DIR

Address: Operational Base + offset (0x0010)

GPIO2A / GPIO2B output enable control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio2b_dir</p> <p>GPIO2B output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default)</p> <p>1:Output</p>
7:0	RW	0x00	<p>gpio2a_dir</p> <p>GPIO2A output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default)</p> <p>1:Output</p>

GRF_GPIO2H_DIR

Address: Operational Base + offset (0x0014)

GPIO2C / GPIO2D output enable control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio2d_dir</p> <p>GPIO2D output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>
7:0	RW	0x00	<p>gpio2c_dir</p> <p>GPIO2C output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>

GRF_GPIO3L_DIR

Address: Operational Base + offset (0x0018)

GPIO3A / GPIO3B output enable control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio3b_dir</p> <p>GPIO3B output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>
7:0	RW	0x00	<p>gpio3a_dir</p> <p>GPIO3A output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>

GRF_GPIO3H_DIR

Address: Operational Base + offset (0x001c)

GPIO3C / GPIO3D output enable control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio3d_dir</p> <p>GPIO3D output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>
7:0	RW	0x00	<p>gpio3c_dir</p> <p>GPIO3C output enable control</p> <p>When system is forced into power down mode, Values written to this register independently control the direction of the corresponding data bit in GPIO bits .</p> <p>0: Input (default) 1:Output</p>

GRF_GPIO0L_DO

Address: Operational Base + offset (0x0020)

GPIO0A / GPIO0B output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio0b_do</p> <p>GPIO0B output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio0a_do</p> <p>GPIO0A output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO0H_DO

Address: Operational Base + offset (0x0024)

GPIO0C / GPIO0D output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio0d_do</p> <p>GPIO0D output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio0c_do</p> <p>GPIO0C output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO1L_DO

Address: Operational Base + offset (0x0028)

GPIO1A / GPIO1B output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio1b_do</p> <p>GPIO1B output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio1a_do</p> <p>GPIO1A output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO1H_DO

Address: Operational Base + offset (0x002c)

GPIO1C / GPIO1D output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio1d_do</p> <p>GPIO1D output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio1c_do</p> <p>GPIO1C output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO2L_DO

Address: Operational Base + offset (0x0030)

GPIO2A / GPIO2B output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio2b_do</p> <p>GPIO2B output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio2a_do</p> <p>GPIO2A output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO2H_DO

Address: Operational Base + offset (0x0034)

GPIO2C / GPIO2D output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio2d_do</p> <p>GPIO2D output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio2c_do</p> <p>GPIO2C output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO3L_DO

Address: Operational Base + offset (0x0038)

GPIO3A / GPIO3B output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio3b_do</p> <p>GPIO3B output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio3a_do</p> <p>GPIO3A output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO3H_DO

Address: Operational Base + offset (0x003c)

GPIO3C / GPIO3D output control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio3d_do</p> <p>GPIO3D output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>
7:0	RW	0x00	<p>gpio3c_do</p> <p>GPIO3C output control</p> <p>When system is forced into power down mode, Values written to this register are output on the I/O signals for GPIO if the corresponding data direction bits for GPIO are set to output mode.</p>

GRF_GPIO0L_EN

Address: Operational Base + offset (0x0040)

GPIO0A / GPIO0B output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio0b_en</p> <p>GPIO0B output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio0a_en</p> <p>GPIO0A output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO0H_EN

Address: Operational Base + offset (0x0044)

GPIO0C / GPIO0D output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio0d_en</p> <p>GPIO0D output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio0c_en</p> <p>GPIO0C output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO1L_EN

Address: Operational Base + offset (0x0048)

GPIO1A / GPIO1B output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio1b_en</p> <p>GPIO1B output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio1a_en</p> <p>GPIO1A output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO1H_EN

Address: Operational Base + offset (0x004c)

GPIO1C / GPIO1D output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio1d_en</p> <p>GPIO1D output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio1c_en</p> <p>GPIO1C output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO2L_EN

Address: Operational Base + offset (0x0050)

GPIO2A / GPIO2B output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio2b_en</p> <p>GPIO2B output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio2a_en</p> <p>GPIO2A output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO2H_EN

Address: Operational Base + offset (0x0054)

GPIO2C / GPIO2D output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio2d_en</p> <p>GPIO2D output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio2c_en</p> <p>GPIO2C output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO3L_EN

Address: Operational Base + offset (0x0058)

GPIO3A / GPIO3B output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio3b_en</p> <p>GPIO3B output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio3a_en</p> <p>GPIO3A output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO3H_EN

Address: Operational Base + offset (0x005c)

GPIO3C / GPIO3D output enable

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RW	0x00	<p>gpio3d_en</p> <p>GPIO3D output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>
7:0	RW	0x00	<p>gpio3c_en</p> <p>GPIO3C output enable</p> <p>When system is forced into power down mode, Values written to this register will enable whether GPIO status will be controlled by GRF register</p>

GRF_GPIO0A_IOMUX

Address: Operational Base + offset (0x0060)

GPIO0A iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:0	RO	0x0	reserved

GRF_GPIO0B_IOMUX

Address: Operational Base + offset (0x0064)

GPIO0B iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:0	RO	0x0	reserved

GRF_GPIO0C_IOMUX

Address: Operational Base + offset (0x0068)

GPIO0C iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15	RO	0x0	reserved
14	RW	0x0	<p>gpio0c7_sel</p> <p>GPIO0C[7] iomux select</p> <p>1: flash data 15</p> <p>0: gpio</p>
13	RO	0x0	reserved
12	RW	0x0	<p>gpio0c6_sel</p> <p>GPIO0C[6] iomux select</p> <p>1: flash data 14</p> <p>0: gpio</p>
11	RO	0x0	reserved
10	RW	0x0	<p>gpio0c5_sel</p> <p>GPIO0C[5] iomux select</p> <p>1: flash data 13</p> <p>0: gpio</p>
9	RO	0x0	reserved
8	RW	0x0	<p>gpio0c4_sel</p> <p>GPIO0C[4] iomux select</p> <p>1: fash data 12</p> <p>0: gpio</p>
7	RO	0x0	reserved
6	RW	0x0	<p>gpio0c3_sel</p> <p>GPIO0C[3] iomux select</p> <p>1: flash data 11</p> <p>0: gpio</p>
5	RO	0x0	reserved

Bit	Attr	Reset Value	Description
4	RW	0x0	gpio0c2_sel GPIO0C[2] iomux select 1: flash data 10 0: gpio
3	RO	0x0	reserved
2	RW	0x0	gpio0c1_sel GPIO0C[1] iomux select 1: flash data9 0: gpio
1	RO	0x0	reserved
0	RW	0x0	gpio0c0_sel GPIO0C[0] iomux select 1: flash data8 0: gpio

GRF_GPIOOD_IOMUX

Address: Operational Base + offset (0x006c)
GPIOOD iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15	RO	0x0	reserved
14	RW	0x0	gpio0d7_sel GPIO0D[5] iomux select 1: spi1_csn0 0: gpio
13	RO	0x0	reserved

Bit	Attr	Reset Value	Description
12	RW	0x0	gpio0d6_sel GPIO0D[5] iomux select 1: spi1_clk 0: gpio
11	RO	0x0	reserved
10	RW	0x0	gpio0d5_sel GPIO0D[5] iomux select 1: spi1_txd 0: gpio
9	RO	0x0	reserved
8	RW	0x0	gpio0d4_sel GPIO0D[4] iomux select 1: spi1_rxd 0: gpio
7:6	RW	0x0	gpio0d3_sel GPIO0D[3] iomux select 01: flash_csn3 10: emmc_rstn_out 11: reserved 00: gpio
5:4	RW	0x0	gpio0d2_sel GPIO0D[2] iomux select 01: flash_csn2 10: emmc_cmd 11: reserved 00: gpio
3	RO	0x0	reserved
2	RW	0x0	gpio0d1_sel GPIO0D[1] iomux select 1: flash_csn1 0: gpio
1:0	RW	0x0	gpio0d0_sel GPIO0D[0] iomux select 01: flash_dqs 10: emmc_clkout 11: reserved 00: gpio

GRF_GPIO1A_IOMUX

Address: Operational Base + offset (0x0070)
 GPIO1A iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RW	0x0	<p>gpio1a7_sel</p> <p>GPIO1A[7] iomux select</p> <p>01: uart1_rts_n</p> <p>10: spi0_csn0</p> <p>11: reserved</p> <p>00: gpio</p>
13:12	RW	0x0	<p>gpio1a6_sel</p> <p>GPIO1A[6] iomux select</p> <p>01: uart1_cts_n</p> <p>10:spi0_clk</p> <p>11: reserved</p> <p>00: gpio</p>
11:10	RW	0x0	<p>gpio1a5_sel</p> <p>GPIO1A[5] iomux select</p> <p>01: uart1_sout</p> <p>10: spi0_txd</p> <p>11: reserved</p> <p>00: gpio</p>
9:8	RW	0x0	<p>gpio1a4_sel</p> <p>GPIO1A[4] iomux select</p> <p>01: uart1_sin</p> <p>10: spi0_rxd</p> <p>11: reserved</p> <p>00: gpio</p>
7	RO	0x0	reserved

Bit	Attr	Reset Value	Description
6	RW	0x0	gpio1a3_sel GPIO1A[3] iomux select 1: uart0_rts_n 0: gpio
5	RO	0x0	reserved
4	RW	0x0	gpio1a2_sel GPIO1A[2] iomux select 1: uart0_cts_n 0: gpio
3	RO	0x0	reserved
2	RW	0x0	gpio1a1_sel GPIO1A[1] iomux select 1: uart0_sout 0: gpio
1	RO	0x0	reserved
0	RW	0x0	gpio1a0_sel GPIO1A[0] iomux select 1: uart0_sin 0: gpio

GRF_GPIO1B_IOMUX

Address: Operational Base + offset (0x0074)

GPIO1B iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15	RO	0x0	reserved

Bit	Attr	Reset Value	Description
14	RW	0x0	gpio1b7_sel GPIO1B[7] iomux select 1: spi0_csn1 0: gpio
13:12	RW	0x0	gpio1b6_sel GPIO1B[6] iomux select 01: spdif_tx 10: spi1_csn1 11: reserved 00: gpio
11	RO	0x0	reserved
10	RW	0x0	gpio1b5_sel GPIO1B[5] iomux select 1: uart3_rts_n 0: gpio
9:8	RW	0x0	gpio1b4_sel GPIO1B[4] iomux select 01: uart3_cts_n 10: gps_rfclk 11: reserved 00: gpio
7:6	RW	0x0	gpio1b3_sel GPIO1B[3] iomux select 01: uart3_sout 10: gps_sig 11: reserved 00: gpio
5:4	RW	0x0	gpio1b2_sel GPIO1B[2] iomux select 01: uart3_sin 10: gps_mag 11: reserved 00: gpio
3:2	RW	0x0	gpio1b1_sel GPIO1B[1] iomux select 01: uart2_sout 10: jtag_tdo (or set jtag_sel=1 on board level) 11: reserved 00: gpio

Bit	Attr	Reset Value	Description
1:0	RW	0x0	gpio1b0_sel GPIO1B[0] iomux select 01: uart2_sin 10: jtag_tdi (or set jtag_sel =1 on board level) 11: reserved 00: gpio

GRF_GPIO1C_IOMUX

Address: Operational Base + offset (0x0078)

GPIO1C iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:12	RO	0x0	reserved
11:10	RW	0x0	gpio1c5_sel GPIO1C[5] iomux select 1: i2s_sdo 0: gpio
9	RO	0x0	reserved
8	RW	0x0	gpio1c4_sel GPIO1C[4] iomux select 1: i2s_sdi 0: gpio
7	RO	0x0	reserved

Bit	Attr	Reset Value	Description
6	RW	0x0	gpio1c3_sel GPIO1C[3] iomux select 1: i2s_lrck_tx 0: gpio
5	RO	0x0	reserved
4	RW	0x0	gpio0c2_sel GPIO0C[2] iomux select 1: i2s_lrclk_rx 0: gpio
3	RO	0x0	reserved
2	RW	0x0	gpio1c1_sel GPIO1C[1] iomux select 1: i2s_sclk 0: gpio
1	RO	0x0	reserved
0	RW	0x0	gpio1c0_sel GPIO1C[0] iomux select 1: i2s_clk 0: gpio

GRF_GPIO1D_IOMUX

Address: Operational Base + offset (0x007c)

GPIO1D iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15	RO	0x0	reserved

Bit	Attr	Reset Value	Description
14	RW	0x0	gpio1d7_sel GPIO1D[7] iomux select 1: i2c4_scl 0: gpio
13	RO	0x0	reserved
12	RW	0x0	gpio1d6_sel GPIO1D[6] iomux select 1: i2c4_sda 0: gpio
11	RO	0x0	reserved
10	RW	0x0	gpio1d5_sel GPIO1D[5] iomux select 1: i2c2_scl 0: gpio
9	RO	0x0	reserved
8	RW	0x0	gpio1d4_sel GPIO1D[4] iomux select 1: i2c2_sda 0: gpio
7	RO	0x0	reserved
6	RW	0x0	gpio1d3_sel GPIO1D[3] iomux select 1: i2c1_scl 0: gpio
5	RO	0x0	reserved
4	RW	0x0	gpio1d2_sel GPIO1D[2] iomux select 1: i2c1_sda 0: gpio
3	RO	0x0	reserved
2	RW	0x0	gpio1d1_sel GPIO1D[1] iomux select 1: i2c0_scl 0: gpio
1	RO	0x0	reserved
0	RW	0x0	gpio1d0_sel GPIO1D[0] iomux select 1: i2c0_sda 0: gpio

GRF_GPIO2A_IOMUX

Address: Operational Base + offset (0x0080)
 GPIO2A iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RW	0x0	<p>gpio2a7_sel</p> <p>GPIO2A[7] iomux select</p> <p>01: lcdc1_data7</p> <p>10: smc_data7</p> <p>11: trace_data7</p> <p>00: gpio</p>
13:12	RW	0x0	<p>gpio2a6_sel</p> <p>GPIO2A[6] iomux select</p> <p>01: lcdc1_data6</p> <p>10: smc_data6</p> <p>11: trace_data6</p> <p>00: gpio</p>
11:10	RW	0x0	<p>gpio2a5_sel</p> <p>GPIO2A[5] iomux select</p> <p>01: lcdc1_data5</p> <p>10: smc_data5</p> <p>11: trace_data5</p> <p>00: gpio</p>
9:8	RW	0x0	<p>gpio2a4_sel</p> <p>GPIO2A[4] iomux select</p> <p>01: lcdc1_data4</p> <p>10: smc_data4</p> <p>11: trace_data4</p> <p>00: gpio</p>

Bit	Attr	Reset Value	Description
7:6	RW	0x0	gpio2a3_sel GPIO2A[3] iomux select 01: lcdc1_data3 10: smc_data3 11: trace_data3 00: gpio
5:4	RW	0x0	gpio2a2_sel GPIO2A[2] iomux select 01: lcdc1_data2 10: smc_data2 11: trace_data2 00: gpio
3:2	RW	0x0	gpio2a1_sel GPIO2A[1] iomux select 01: lcdc1_data1 10: smc_data1 11: trace_data1 00: gpio
1:0	RW	0x0	gpio2a0_sel GPIO2A[0] iomux select 01: lcdc1_data0 10: smc_data0 11: trace_data0 00: gpio

GRF_GPIO2B_IOMUX

Address: Operational Base + offset (0x0084)
 GPIO2B iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RW	0x0	<p>gpio2b7_sel</p> <p>GPIO2B[7] iomux select</p> <p>01: lcdc1_data15</p> <p>10: smc_data15</p> <p>11: trace_data15</p> <p>00: gpio</p>
13:12	RW	0x0	<p>gpio2b6_sel</p> <p>GPIO2B[6] iomux select</p> <p>01: lcdc1_data14</p> <p>10: smc_data14</p> <p>11: trace_data14</p> <p>00: gpio</p>
11:10	RW	0x0	<p>gpio2b5_sel</p> <p>GPIO2B[5] iomux select</p> <p>01: lcdc1_data13</p> <p>10: smc_data13</p> <p>11: trace_data13</p> <p>00: gpio</p>
9:8	RW	0x0	<p>gpio2b4_sel</p> <p>GPIO2B[4] iomux select</p> <p>01: lcdc1_data12</p> <p>10: smc_data12</p> <p>11: trace_data12</p> <p>00: gpio</p>

Bit	Attr	Reset Value	Description
7:6	RW	0x0	gpio2b3_sel GPIO2B[3] iomux select 01: lcdc1_data11 10: smc_data11 11: trace_data11 00: gpio
5:4	RW	0x0	gpio2b2_sel GPIO2B[2] iomux select 01: lcdc1_data10 10: smc_data10 11: trace_data10 00: gpio
3:2	RW	0x0	gpio2b1_sel GPIO2B[1] iomux select 01: lcdc1_data9 10: smc_data9 11: trace_data9 00: gpio
1:0	RW	0x0	gpio2b0_sel GPIO2B[0] iomux select 01: lcdc1_data8 10: smc_data8 11: trace_data8 00: gpio

GRF_GPIO2C_IOMUX

Address: Operational Base + offset (0x0088)
 GPIO2C iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RW	0x0	<p>gpio2c7_sel</p> <p>GPIO2C[7] iomux select</p> <p>01: lcdc1_data23</p> <p>10: smc_addr7</p> <p>11: reserved</p> <p>00: gpio</p>
13:12	RW	0x0	<p>gpio2c6_sel</p> <p>GPIO2C[6] iomux select</p> <p>01: lcdc1_data22</p> <p>10: smc_addr6</p> <p>11: reserved</p> <p>00: gpio</p>
11:10	RW	0x0	<p>gpio2c5_sel</p> <p>GPIO2C[5] iomux select</p> <p>01: lcdc1_data21</p> <p>10: smc_addr5</p> <p>11: reserved</p> <p>00: gpio</p>
9:8	RW	0x0	<p>gpio2c4_sel</p> <p>GPIO2C[4] iomux select</p> <p>01: lcdc1_data20</p> <p>10: smc_addr4</p> <p>11: reserved</p> <p>00: gpio</p>

Bit	Attr	Reset Value	Description
7:6	RW	0x0	gpio2c3_sel GPIO2C[3] iomux select 01: lcdc1_data19 10: smc_addr3 11: reserved 00: gpio
5:4	RW	0x0	gpio2c2_sel GPIO2C[2] iomux select 01: lcdc1_data18 10: smc_addr2 11: reserved 00: gpio
3:2	RW	0x0	gpio2c1_sel GPIO2C[1] iomux select 01: lcdc1_data17 10: smc_addr1 11: trace_ctl 00: gpio
1:0	RW	0x0	gpio2c0_sel GPIO2C[0] iomux select 01: lcdc1_data16 10: smc_addr0 11: trace_clk 00: gpio

GRF_GPIO2D_IOMUX

Address: Operational Base + offset (0x008c)

GPIO2D iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15	RO	0x0	reserved
14	RW	0x0	<p>gpio2d7_sel</p> <p>GPIO2D[7] iomux select</p> <p>1: test_clock_out</p> <p>0: gpio</p>
13	RO	0x0	reserved
12	RW	0x0	<p>gpio2d6_sel</p> <p>GPIO2D[6] iomux select</p> <p>1: smc_csn1</p> <p>0: gpio</p>
11	RO	0x0	reserved
10	RW	0x0	<p>gpio2d5_sel</p> <p>GPIO2D[5] iomux select</p> <p>1: smc_bls_n1</p> <p>0: gpio</p>
9	RO	0x0	reserved
8	RW	0x0	<p>gpio2d4_sel</p> <p>GPIO2D[4] iomux select</p> <p>1: smc_bls_n0</p> <p>0: gpio</p>
7:6	RW	0x0	<p>gpio2d3_sel</p> <p>GPIO2D[3] iomux select</p> <p>01: lcdc1_vsync</p> <p>10: smc_adv_n</p> <p>11: reserved</p> <p>00: gpio</p>

Bit	Attr	Reset Value	Description
5:4	RW	0x0	gpio2d2_sel GPIO2D[2] iomux select 01: lcdc1_hsync 10: smc_oe_n 11: reserved 00: gpio
3:2	RW	0x0	gpio2d1_sel GPIO2D[1] iomux select 01: lcdc1_den 10: smc_we_n 11: reserved 00: gpio
1:0	RW	0x0	gpio2d0_sel GPIO2D[0] iomux select 01: lcdc1_dclk 10: smc_csn0 11: reserved 00: gpio

GRF_GPIO3A_IOMUX

Address: Operational Base + offset (0x0090)
 GPIO3A iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15	RO	0x0	reserved
14	RW	0x0	gpio3a7_sel GPIO3A[7] iomux select 1: sdmmc0_data3 0: gpio

Bit	Attr	Reset Value	Description
13	RO	0x0	reserved
12	RW	0x0	gpio3a6_sel GPIO3A[6] iomux select 1: sdmmc0_data2 0: gpio
11	RO	0x0	reserved
10	RW	0x0	gpio4a5_sel GPIO4A[5] iomux select 1: sdmmc0_data1 0: gpio
9	RO	0x0	reserved
8	RW	0x0	gpio3a4_sel GPIO3A[4] iomux select 1: sdmmc0_data0 0: gpio
7	RO	0x0	reserved
6	RW	0x0	gpio3a3_sel GPIO3A[3] iomux select 1: sdmmc0_cmd 0: gpio
5	RO	0x0	reserved
4	RW	0x0	gpio3a2_sel GPIO3A[2] iomux select 1: sdmmc0_clkout 0: gpio
3	RO	0x0	reserved
2	RW	0x0	gpio3a1_sel GPIO3A[1] iomux select 1: sdmmc0_pwr_en 0: gpio
1	RO	0x0	reserved
0	RW	0x0	gpio3a0_sel GPIO3A[0] iomux select 1: sdmmc0_rstn_out 0: gpio

GRF_GPIO3B_IOMUX

Address: Operational Base + offset (0x0094)
GPIO3B iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RW	0x0	<p>gpio3b7_sel</p> <p>GPIO3B[7] iomux select</p> <p>01: cif_data11</p> <p>10: i2c3_scl</p> <p>00: gpio</p>
13:12	RW	0x0	<p>gpio3b6_sel</p> <p>GPIO3B[6] iomux select</p> <p>01: cif_data10</p> <p>10: i2c3_sda</p> <p>00: gpio</p>
11:10	RW	0x0	<p>gpio3b5_sel</p> <p>GPIO3B[5] iomux select</p> <p>01: cif_data1</p> <p>10: hsadc_data9</p> <p>0: gpio</p>
9:8	RW	0x0	<p>gpio3b4_sel</p> <p>GPIO3B[4] iomux select</p> <p>01: cif_data0</p> <p>10: hsadc_data8</p> <p>0: gpio</p>
7	RO	0x0	reserved
6	RW	0x0	<p>gpio3b3_sel</p> <p>GPIO3B[3] iomux select</p> <p>1: cif_clkout</p> <p>0: gpio</p>
5:3	RO	0x0	reserved

Bit	Attr	Reset Value	Description
2	RW	0x0	gpio3b1_sel GPIO3B[1] iomux select 1: sdmmc0_write_prt 0: gpio
1	RO	0x0	reserved
0	RW	0x0	gpio3b0_sel GPIO3B[0] iomux select 1: sdmmc0_detect_n 0: gpio

GRF_GPIO3C_IOMUX

Address: Operational Base + offset (0x0098)

GPIO3C iomux control

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:14	RW	0x0	gpio3c7_sel GPIO3C[7] iomux select 01: sdmmc1_write_prt 10: rmii_crs 11: reserved 00: gpio
13:12	RW	0x0	gpio3c6_sel GPIO3C[6] iomux select 01: sdmmc1_detect_n 10: rmii_rx_err 11: reserved 00: gpio

Bit	Attr	Reset Value	Description
11:10	RW	0x0	gpio3c5_sel GPIO3C[5] iomux select 01: sdmmc1_clkout 10: rmii_clkout 11: rmii_clkin 00: gpio
9:8	RW	0x0	gpio3c4_sel GPIO3C[4] iomux select 01: sdmmc1_data3 10: rmii_rxd1 11: reserved 00: gpio
7:6	RW	0x0	gpio3c3_sel GPIO3C[3] iomux select 01: sdmmc1_data2 10: rxii_rxd0 11: reserved 00: gpio
5:4	RW	0x0	gpio3c2_sel GPIO3C[2] iomux select 01: sdmmc1_data1 10: rmii_txd0 11: reserved 00: gpio
3:2	RW	0x0	gpio3c1_sel GPIO3C[1] iomux select 01: sdmmc1_data0 10: rmii_txd1 11: reserved 00: gpio
1:0	RW	0x0	gpio3c0_sel GPIO3C[0] iomux select 01: sdmmc1_cmd 10: rmii_tx_en 11: reserved 00: gpio

GRF_GPIO3D_IOMUX

Address: Operational Base + offset (0x009c)
GPIO3D iomux control

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RO	0x0	reserved
13:12	RW	0x0	<p>gpio3d6_sel</p> <p>GPIO3D[6] iomux select</p> <p>01: pwm3</p> <p>10: jtag_tms(or set jtag_sel=1 on board level)</p> <p>11: host_drv_vbus</p> <p>00: gpio</p>
11:10	RW	0x0	<p>gpio3d5_sel</p> <p>GPIO3D[5] iomux select</p> <p>01: pwm2</p> <p>10: jtag_tck (or set jtag_sel=1 on board level)</p> <p>11: otg_drv_vbus</p> <p>00: gpio</p>
9:8	RW	0x0	<p>gpio3d4_sel</p> <p>GPIO3D[4] iomux select</p> <p>01: pwm1</p> <p>10: jtag_trstn (or set jtag_sel=1 on board level)</p> <p>00: gpio</p>
7	RO	0x0	reserved
6	RW	0x0	<p>gpio3d3_sel</p> <p>GPIO3D[3] iomux select</p> <p>1:pwm0</p> <p>0: gpio</p>
5	RO	0x0	reserved

Bit	Attr	Reset Value	Description
4	RW	0x0	gpio3d2_sel GPIO3D[2] iomux select 1: sdmmc1_int_n 0: gpio
3:2	RW	0x0	gpio3d1_sel GPIO3D[1] iomux select 01: sdmmc1_backend_pwr 10: mii_mdclk 11: reserved 00: gpio
1:0	RW	0x0	gpio3d0_sel GPIO3D[0] iomux select 01: sdmmc1_pwr_en 10: mii_md 11: reserved 00: gpio

GRF_SOC_CON0

Address: Operational Base + offset (0x00a0)

soc control register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	write_enable bit 0~bit 15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15	RW	0x0	hsadc_clk_dir hsadc clock direction control 0: clock out 1: clock in

Bit	Attr	Reset Value	Description
14	RW	0x0	hsadc_sel hsadc iomux select control 1: select hsadc function 0: don't select hsadc function
13	RO	0x0	reserved
12	RW	0x0	noc_remap noc remap signal When soc_remap = 1, the bootrom is mapped to address 0x10100000 and internal memory is mapped to address 0x0.
11	RW	0x0	emmc_flash_sel emmc flash select used for iomux IO_FLASH_DATA[7:0] , IO_FLASH_WP are selected for emmc instead of flash
10:7	RW	0x0	tzpc_revision
6:5	RW	0x0	l2cache_acc L2 Cache access control L2 Cache access control 00: accessed by CPU 10: low half accessed by CPU , high half accessed by AXI 11/01: accessed by AXI
4:3	RW	0x1	l2rd_wait L2 Cache read wait cycle 00: the rdata of L2 cache will be captured at the next cycle after read command valid when used as internal memory. 01: the rdata of L2 cache will be captured one cycle later after read command valid when used as internal memory. 10: the rdata of L2 cache will be captured two cycle later after read command valid when used as internal memory. 11: the rdata of L2 cache will be captured three cycle later after read command valid when used as internal memory.

Bit	Attr	Reset Value	Description
2:1	RW	0x1	imemrd_wait IMEM read wait cycle 00: the rdata of internal memory will be captured at the next cycle after read command valid 01: the rdata of internal memory will be captured one cycle later after read command valid 10: the rdata of internal memory will be captured two cycle later after read command valid 11: the rdata of internal memory will be captured three cycle later after read command valid
0	RO	0x0	reserved

GRF_SOC_CON1

Address: Operational Base + offset (0x00a4)

soc control register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	write_enable bit 0~bit 15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:11	RW	0x00	rki2c_sel rki2c select 0: use old i2c 1: rki2c is used instead of old i2c
10	RW	0x0	vpu_sel vdpu vepu clock select 0: select vepu aclk as vpu main clock 1: select vdpu aclk as vpu main clock

Bit	Attr	Reset Value	Description
9	RW	0x0	peri_emem_pause PERI AHB bus arbiter pause control
8	RW	0x0	peri_usb_pause peri usb ahb bus arbiter pause control USB AHB bus arbiter pause control
7	RO	0x0	reserved
6	RW	0x0	smc_mux_mode_0 When high, the smc memory interface operates in multiplexed address/data mode.
5:4	RW	0x0	smc_sram_mw_0 Sets the memory width for smc chip select0, on memory interface 0, when remap_0(grf_soc_con[14]) is high, the encoding is : 00: 8 bit 01: 16 bit 10: 32bit 11: reserved
3	RW	0x0	smc_remap_0 If high, remap smc controller chip select 0 , on memory interface 0 , to address 0x0
2	RW	0x1	smc_a_gt_m0_sync Indicate that if aclk is faster than and synchronous to mclk0 in smc controller 0: aclk is not faster than and synchronous to mclk0 1: aclk is faster than and synchronous to mclk0
1	RW	0x1	emac_speed 0: 10MHz 1: 100MHz
0	RW	0x0	emac_mode 0: rmii 1: mii

GRF_SOC_CON2

Address: Operational Base + offset (0x00a8)
soc control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;</p>
15:8	RO	0x0	reserved
7	RW	0x0	<p>msch4_mainaddr3 When DDR3 is used , software should configure this bit to 1.</p>
6	RW	0x0	<p>emac_newrcv_en the selection of RMII receive selection 0: don't support the data package without header 1: support the data package without header</p>
5	RW	0x0	<p>sw_addr15_en 1 : The axiaddr[15] of L2C axi bus 1 is switched with axiaddr[12] of L2C axi bus 1</p>
4	RW	0x0	<p>sw_addr16_en 1 : The axiaddr[16] of L2C axi bus 1 is switched with axiaddr[13] of L2C axi bus 1</p>
3	RW	0x0	<p>sw_addr17_en 1 : The axiaddr[17] of L2C axi bus 1 is switched with axiaddr[14] of L2C axi bus 1</p>
2	RW	0x0	<p>bank2_to_rank_en 1: bank[2] connect to rank</p>
1	RW	0x0	<p>rank_to_row15_en 0: ddr rank bit not 1: ddr rank bit connect to row[15]</p>

Bit	Attr	Reset Value	Description
0	RW	0x0	upctl_c_active_in ddr clock active in. External signal from system that flags if a hardware low power request can be accepted or should always be denied. 0: may be accepted 1: will be denied

GRF_SOC_STATUS0

Address: Operational Base + offset (0x00ac)

soc status register

Bit	Attr	Reset Value	Description
31:23	RO	0x0	reserved
22	RW	0x0	uhost_adpprb uhost otg_adpprb signal status
21	RW	0x1	uhost_adpsns otg_phy adpsns status
20	RW	0x0	uhost_utmiotg_iddig uhost phy utmiotg_iddig signal status
19:18	RW	0x0	uhost_utmi_linstate otg phy otg_utmi_linstate singal status
17	RW	0x0	uhost_utmisrp_bvalid the otg_phy otg_utmisrp_bvalid status signal
16	RW	0x0	uhost_utmiotg_vbusvalid the uhost phy otg_utmiotg_vbusvalid signal status
15	RW	0x0	otg_adpprb otg_phy otg_adpprb signal status
14	RW	0x1	otg_adpsns otg_phy adpsns status
13	RW	0x1	otg_utmiotg_iddig otg_phy utmiotg_iddig signal status
12:11	RW	0x0	otg_utmi_linstate otg phy otg_utmi_linstate singal status
10	RW	0x0	otg_utmisrp_bvalid the otg_phy otg_utmisrp_bvalid status signal
9	RW	0x0	otg_utmiotg_vbusvalid the otg phy otg_utmiotg_vbusvalid signal status

Bit	Attr	Reset Value	Description
8:5	RW	0xf	pli_lock_status PLL lock status, including APLL, DPLL, CPLL and GPLL bit5: DPLL lock status bit6: APLL lock status bit7: CPLL lock status bit8: GPLL lock status
4	RW	0x0	gpu_idle gpu idle status indication
3	RW	0x0	gpu_cache_snoop indicate whether the gpu access should be snoop by system 0: no cache snoop 1: should be cache snoop
2:0	RO	0x0	timer_en_status

GRF_DMAC0_CON0

Address: Operational Base + offset (0x00b0)

DMAC0 control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:7	RO	0x0	reserved
6:4	RW	0x0	dmac0_boot_addr DMAC0 boot_addr[18:16] input control Configures the address location that contains the first instruction the DMAC executes, when it exits from reset.

Bit	Attr	Reset Value	Description
3	RO	0x0	reserved
2:1	RW	0x1	dmac0_drtype DMAC0 type of acknowledgement or request for peripheral signals: 00 : single level request 01 : burst level request 10 : acknowledging a flush request 11 : reserved
0	RW	0x0	dmac0_boot_from_pc dmac0_boot_from_pc DMAC0 boot_from_pc input control Controls the location in which the DMAC0 executes its initial instruction, after it exits from reset : 0= DMAC0 waits for an instruction from APB interface 1= DMAC manager thread executes the instruction that is located at the address that boot_addr[31:0] provided.

GRF_DMAC0_CON1

Address: Operational Base + offset (0x00b4)

DMAC1 control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	dmac0_boot_addr DMAC0 boot_addr[15:0] input control Configures the address location that contains the first instruction the DMAC executes, when it exits from reset.

GRF_DMAC0_CON2

Address: Operational Base + offset (0x00b8)

DMAC0 control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:8	RW	0x00	dmac0_boot_irq_ns DMAC1 boot_irq_ns[11:4] input control Controls the security state of an event-interrupt resource , when the DMAC1 exits from reset. Note : DMAC1 don't support secure feature, these bits don't need to be configured.
7:0	RW	0x00	dmac0_boot_periph_ns DMAC1 boot_peri_ns[11:4] input control Controls the security state of a peripheral request interface, when the DMAC1 exits from reset. Note: DMAC1 don't support secure feature, these bits don't need to be configured.

GRF_DMAC1_CON0

Address: Operational Base + offset (0x00bc)

DMAC1 control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;</p>
15:2	RW	0x3fff	<p>dmac1_boot_irq_ns DMAC1 boot_irq_ns input control Controls the security state of an event-interrupt resource , when the DMAC1 exits from reset. Note: DMAC1 don't support secure feature , these bits don't need to be configured.</p>
1	RW	0x1	<p>dmac1_boot_manager_ns DMAC1 boot_manager_ns input control When the DMAC1 exits from reset , this signal controls the security state of the DMA manager thread: 0 = assigns DMA manager to the secure state 1 = assigns DMA manager to the Non-secure state</p>
0	RW	0x0	<p>dmac1_boot_from_pc dmac1_boot_from_pc DMAC1 boot_from_pc input control Controls the location in which the DMAC1 executes its initial instruction, after it exits from reset : 0= DMAC1 waits for an instruction from APB interface 1= DMAC manager thread executes the instruction that is located at the address that boot_addr[31:0] provided.</p>

GRF_DMAC1_CON1

Address: Operational Base + offset (0x00c0)

DMAC1 control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x3fff	<p>dmac1_boot_addr</p> <p>dmac1_boot_addr[27:12]</p> <p>DMAC1 boot_addr[27:12] input control</p> <p>Configures the address location that contains the first instruction the DMAC executes, when it exits from reset.</p>

GRF_DMAC1_CON2

Address: Operational Base + offset (0x00c4)

DMAC1 control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:10	RO	0x0	reserved
9:6	RW	0x0	<p>dmac1_boot_periph_ns</p> <p>DMAC1 boot_peri_ns[19:16] input control</p> <p>Controls the security state of a peripheral request interface , when the DMAC1 exits from reset.</p> <p>Note: DMAC1 don't support secure feature, these bits don't need to be configured.</p>
5:4	RW	0x0	<p>dmac1_drtype</p> <p>DMAC1 type of acknowledgement or request for peripheral signals:</p> <p>00 : single level request</p> <p>01 : burst level request</p> <p>10 : acknowledging a flush request</p> <p>11 : reserved</p>
3:0	RW	0xf	<p>dmac1_boot_addr</p> <p>dmac1_boot_addr[31:28]</p> <p>DMAC1 boot_addr[31:28] input control</p> <p>Configures the address location that contains the first instruction the DMAC executes, when it exits from reset.</p>

GRF_DMAC1_CON3

Address: Operational Base + offset (0x00c8)
 DMAC1 control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x3fff	<p>dmac1_boot_perph_ns</p> <p>DMAC1 boot_peri_ns[19:16] input control</p> <p>Controls the security state of a peripheral request interface, when the DMAC1 exits from reset.</p> <p>Note: DMAC1 don't support secure feature, these bits don't need to be configured.</p>

GRF_CPU_CON0

Address: Operational Base + offset (0x00cc)
cpu core sub-system configuration control

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15	RW	0x1	I2c_cfgaddrfilteren I2c cfgaddrfilteren bit control
14	RW	0x0	I2c_cfbigend I2c cfbigned bit control
13	RW	0x0	a9_filteren Cortex-A9 filteren bit control
12	RO	0x0	reserved
11:9	RW	0x2	I2c_waysize I2c waysize bit control

Bit	Attr	Reset Value	Description
8:7	RW	0x0	a9_pwrctli1 Cortex-A9 core1 pwrctli bit control
6:5	RW	0x0	a9_pwrctli0 Cortex-A9 core0 pwrctli bit control
4	RW	0x0	I2c_associativity L2C associativity bit control
3	RW	0x0	a9_eventi Cortex-A9 eventi bit control
2:0	RW	0x7	a9_maxclklatency Cortex-A9 max clock latency control Cortex-A9 maxclklatency bit control

GRF_CPU_CON1

Address: Operational Base + offset (0x00d0)

cpu core sub-system configuration constrol

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15	RW	0x0	a9_scuevabort Cortex-A9 scuevabort bit control
14	RO	0x0	reserved
13:12	RW	0x0	a9_teinit Cortex-A9 teinit bit control
11:10	RO	0x0	reserved
9:8	RW	0x0	a9_vinithi Cortex-A9 vinithi bit control
7:6	RO	0x0	reserved
5:4	RW	0x0	a9_cfgnmfi Cortex-A9 cfgnmfi bit control
3:2	RO	0x0	reserved
1:0	RW	0x0	a9_cfgend Cortex-A9 cfgend bit control

GRF_CPU_CON2

Address: Operational Base + offset (0x00d4)
cpu core sub-system configuration control

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14	RW	0x1	dap_deviceen Cortex-A9 debug DAP deviceen bit control
13:12	RO	0x0	reserved
11:0	RW	0x000	a9_filterstart Cortex-A9 filter start address

GRF_CPU_CON3

Address: Operational Base + offset (0x00d8)
cpu core sub-system configuration control

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0x000	a9_filterend Cortex-A9 filter end address

GRF_CPU_CON4

Address: Operational Base + offset (0x00dc)
cpu core sub-system configuration control

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0x600	I2c_filterstart L2C filter address start

GRF_CPU_CON5

Address: Operational Base + offset (0x00e0)
cpu core sub-system configuration control

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0xe00	I2c_filterend L2C filter address end

GRF_DDRC_CON0

Address: Operational Base + offset (0x00ec)
DDRC control register

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:13	RO	0x0	reserved
12:11	RW	0x0	<p>dto_lb</p> <p>DTO I/O internal loopback enable</p>
10:9	RW	0x0	<p>dto_te</p> <p>DTO I/O on-die termination enable</p>
8:7	RW	0x0	<p>dto_pdr</p> <p>DTO I/O receiver power down</p>
6:5	RW	0x0	<p>dto_pdd</p> <p>DTO I/O driver power down</p>
4:3	RW	0x0	<p>dto_iom</p> <p>DTO I/O mode select</p>
2:1	RW	0x0	<p>dto_oe</p> <p>DTO I/O output enable</p>
0	RW	0x0	<p>ato_ae</p> <p>Enables, if set, the analog test output I/O.</p> <p>Connects to the AE pin of the analog test output I/O</p>

GRF_DDRC_STAT

Address: Operational Base + offset (0x00f0)

DDRC status

Bit	Attr	Reset Value	Description
31:19	RO	0x0	reserved

Bit	Attr	Reset Value	Description
18:16	RO	0x0	ddrupctl_stat 3'b000 = Init_mem 3'b001 = Config 3'b010 = Config_req 3'b011 = Access 3'b100 = Access_req 3'b101 = Low_power 3'b110 = Low_power_entry_req 3'b111 = Low_power_exit_req
15:0	RO	0x0000	ddrupctl_bbflags NIF output vector which provides combined information about the status of each memory bank. The de-assertion is based on when precharge, activates, reads/writes. Bit0 indication Bank0 busy, bit1 indication Bank1 busy, and so on.

GRF_IO_CON0

Address: Operational Base + offset (0x00f4)

IO drive strength configuration

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:14	RW	0x0	drive_strength_ctrl_6 gpio1, uart3 and spi1 drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA

Bit	Attr	Reset Value	Description
13:12	RW	0x0	drive_strength_ctrl_5 gpio1 and uart2 drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
11:10	RW	0x0	drive_strength_ctrl_4 gpio1, uart1, spi0 drive strength bit control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
9:8	RW	0x0	drive_strength_ctrl_3 gpio1 and uart drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
7:6	RW	0x0	drive_strength_ctrl_2 gpio0_d drive strength constrl 00: 2mA 01: 4mA 10: 8mA 11: 12mA
5:4	RW	0x1	drive_strength_ctrl_1 gpio0 and flash drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
3:2	RW	0x2	drive_strength_ctrl_0 gpio0 and flash drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
1:0	RO	0x0	reserved

GRF_IO_CON1

Address: Operational Base + offset (0x00f8)

IO drive strength configuration

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RW	0x3	<p>drive_strength_ctrl_14</p> <p>gpio2 and lcdc1 drive strength control</p> <p>00: 2mA</p> <p>01: 4mA</p> <p>10: 8mA</p> <p>11: 12mA</p>
13:12	RW	0x0	<p>drive_strength_ctrl_13</p> <p>gpio1 and i2c4 drive strength control</p> <p>00: 2mA</p> <p>01: 4mA</p> <p>10: 8mA</p> <p>11: 12mA</p>
11:10	RW	0x0	<p>drive_strength_ctrl_12</p> <p>gpio1 and i2c2 drive strength control</p> <p>00: 2mA</p> <p>01: 4mA</p> <p>10: 8mA</p> <p>11: 12mA</p>
9:8	RW	0x0	<p>drive_strength_ctrl_11</p> <p>gpio1 and i2c1 drive strength control</p> <p>00: 2mA</p> <p>01: 4mA</p> <p>10: 8mA</p> <p>11: 12mA</p>

Bit	Attr	Reset Value	Description
7:6	RW	0x0	drive_strength_ctrl_10 gpio1 and i2c0 drive strength control0: 2mA 01: 4mA 10: 8mA 11: 12mA
5:4	RW	0x0	drive_strength_ctrl_9 gpio1_c drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
3:2	RW	0x0	drive_strength_ctrl_8 gpio1 and i2s drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
1:0	RW	0x1	drive_strength_ctrl_7 gpio1 and i2s drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA

GRF_IO_CON2

Address: Operational Base + offset (0x00fc)

IO drive strength configuration

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;

Bit	Attr	Reset Value	Description
15:14	RW	0x0	drive_strength_ctrl_22 gpio3 and cif drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
13:12	RW	0x1	drive_strength_ctrl_21 gpio3 and cif drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
11:10	RW	0x0	drive_strength_ctrl_20 gpio3_b drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
9:8	RW	0x0	drive_strength_ctrl_19 gpio3 and sdmmc drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
7:6	RW	0x0	drive_strength_ctrl_18 gpio3 and sdmmc drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
5:4	RW	0x1	drive_strength_ctrl_17 gpio2 and test drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
3:2	RW	0x1	drive_strength_ctrl_16 drive_strength_ctrl_16 gpio2 and smc drive strength bit control 00: 2mA 01: 4mA 10: 8mA 11: 12mA

Bit	Attr	Reset Value	Description
1:0	RW	0x2	drive_strength_ctrl_15 gpio2 and lcdc1 drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA

GRF_IO_CON3

Address: Operational Base + offset (0x0100)

IO drive strength configuration

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:14	RW	0x3	drive_strength_ctrl_30 lcdc0 drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
13:12	RW	0x0	drive_strength_ctrl_29 cif drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA

Bit	Attr	Reset Value	Description
11:10	RW	0x0	drive_strength_ctrl_28 flash drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
9:8	RW	0x2	drive_strength_ctrl_27 flash drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
7:6	RW	0x1	drive_strength_ctrl_26 gpio3_d drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
5:4	RW	0x0	drive_strength_ctrl_25 gpio3 and pwm drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
3:2	RW	0x0	drive_strength_ctrl_24 gpio3 and sdio drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
1:0	RW	0x1	drive_strength_ctrl_23 gpio3 and sdio drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA

GRF_IO_CON4

Address: Operational Base + offset (0x0104)
IO drive strength configuration

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15	RW	0x0	<p>lcdc1_io_vol_ctrl</p> <p>LCDC1 IO domain PAD output voltage control</p> <p>0: 2.5V/3.3V</p> <p>1: 1.8V</p>
14	RW	0x0	<p>lcdc0_io_vol_ctrl</p> <p>LCDC0 IO domain PAD output voltage control</p> <p>0: 2.5V/3.3V</p> <p>1: 1.8V</p>
13	RW	0x0	<p>gpio1_io_vol_ctrl</p> <p>GPIO1 IO domain PAD output voltage control</p> <p>0: 2.5V/3.3V</p> <p>1: 1.8V</p>
12	RW	0x0	<p>gpio0_io_vol_ctrl</p> <p>GPIO0 IO domain PAD output voltage control</p> <p>0: 2.5V/3.3V</p> <p>1: 1.8V</p>
11	RW	0x0	<p>flash_io_vol_ctrl</p> <p>FLASH IO domain PAD output voltage control</p> <p>0: 2.5V/3.3V</p> <p>1: 1.8V</p>
10	RW	0x0	<p>cif_io_vol_ctrl</p> <p>CIF IO domain PAD output voltage control</p> <p>0: 2.5V/3.3V</p> <p>1: 1.8V</p>
9	RW	0x0	<p>ap1_io_vol_ctrl</p> <p>AP1 IO domain PAD output voltage control</p> <p>0: 2.5V/3.3V</p> <p>1: 1.8V</p>

Bit	Attr	Reset Value	Description
8	RW	0x0	ap0_io_vol_ctrl AP0 IO domain PAD output voltage control 0: 2.5V/3.3V 1: 1.8V
7:6	RO	0x0	reserved
5:4	RW	0x1	drive_strength_ctrl_33 misc drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
3:2	RW	0x0	drive_strength_ctrl_32 jtag drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA
1:0	RW	0x2	drive_strength_ctrl_31 lcdc0 drive strength control 00: 2mA 01: 4mA 10: 8mA 11: 12mA

GRF_SOC_STATUS1

Address: Operational Base + offset (0x0108)
soc status register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	gps_debug gps debug register

GRF_UOC0_CON0

Address: Operational Base + offset (0x010c)
otg control register

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15	RW	0x1	<p>usbphy_txbitstuff_enh</p> <p>High-Byte Transmit Bit-Stuffing Enable</p> <p>Function: This controller signal controls bit stuffing on DATAINH[7:0] when OPMODE[1:0] = 2'b11.</p> <p>1: Bit stuffing is enabled.</p> <p>0: Bit stuffing is disabled.</p>
14	RW	0x1	<p>usbphy_txbitstuff_en</p> <p>Low-Byte Transmit Bit-Stuffing Enable</p> <p>Function: This controller signal controls bit stuffing on DATAINH[7:0] when OPMODE[1:0] = 2'b11.</p> <p>1: Bit stuffing is enabled.</p> <p>0: Bit stuffing is disabled.</p>
13	RW	0x0	<p>usbphy_siddq</p> <p>IDDQ Test Enable</p> <p>Function: This test signal enables you to perform IDDQ testing by powering down all analog blocks.</p> <p>1: The analog blocks are powered down.</p> <p>0: The analog blocks are powered up.</p>

Bit	Attr	Reset Value	Description
12	RW	0x0	<p>usbphy_port_reset Per-Port Reset Function: When asserted, this customer-specific signal resets the corresponding port transmit and receive logic without disabling the clocks within the USB 2.0 pico PHY.</p> <p>1: The transmit and receive finite state machines (FSMs) are reset, and the line_state logic combinatorially reflects the state of the single-ended receivers. 0: The transmit and receive FSMs are operational, and the line_state logic becomes sequential after 11 PHYCLOCK cycles.</p>
11:10	RW	0x2	<p>usbphy_refclk_sel Reference Clock Select for PLL Block Function: This signal selects the reference clock source for the PLL block.</p> <p>11: Reserved 10: The PLL uses CLKCORE as reference. 01: The XO block uses an external, 1.8-V clock supplied on the XO pin. 00: The XO block uses the clock from a crystal.</p>
9:8	RW	0x0	<p>scaledown Scale-Down Mode 00: Disables all scale-downs. Actual timing values are used. Required for synthesis. 01: Enables scale-down of all timing values except Device mode suspend and resume. These include: - Speed enumeration. - HNP/SRP. - Host mode suspend and resume. 10: Enables scale-down of Device mode suspend and resume timing values only. 11: Enables bit 0 and bit 1 scale-down timing values.</p>

Bit	Attr	Reset Value	Description
7:5	RW	0x3	<p>usbphy_otg_tune VBUS Valid Threshold Adjustment Function: This bus adjusts the voltage level for the VBUS Valid threshold.</p> <p>111: + 9% 110: + 6% 101: + 3% 100: Design default 011:- 3% 010:- 6% 001: - 9% 000: - 12%</p>
4	RW	0x0	<p>usbphy_otg_disable OTG Block Disable 1: the OTG block is power down 0: the OTG block is power up</p>
3:1	RW	0x1	<p>usbphy_compdistune Disconnect Threshold Adjustment Function: This bus adjusts the voltage level for the threshold used to detect a disconnect event at the host.</p> <p>111: + 4.5% 110: + 3% 101: + 1.5% 100: Design default 011: - 1.5% 010: - 3% 001: - 4.5% 000: - 6%</p>
0	RW	0x1	<p>usb_phy_common_on_n Common Block Power-Down Control Function: This signal controls the power-down signals in the XO, Bias, and PLL blocks when the USB 2.0 PHY is in Suspend or Sleep mode.</p> <p>1: In Suspend mode, the XO, Bias, and PLL blocks are powered down. In Sleep mode, the Bias and PLL blocks are powered down. 0: In Suspend mode, the XO, Bias, and PLL blocks remain powered in Suspend mode. In Sleep mode, if the reference clock is a crystal, the XO block remains powered.</p>

GRF_UOC0_CON1

Address: Operational Base + offset (0x0110)
otg control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:14	RW	0x0	<p>usbphy_txrise_tune</p> <p>HS Transmitter Rise/Fall Time Adjustment</p> <p>Function: This bus adjusts the rise/fall times of the high-speed waveform.</p> <p>11: -20%</p> <p>10: -15%</p> <p>01: design default</p> <p>00: +10%</p>
13:12	RW	0x1	<p>usbphy_txhsxv_tune</p> <p>Transmitter High-Speed Crossover Adjustment</p> <p>Function: This bus adjusts the voltage at which the DP and DM signals cross while transmitting in HS mode.</p> <p>11: Default setting</p> <p>10: + 15 mV</p> <p>01: - 15 mV</p> <p>00: Reserved</p>

Bit	Attr	Reset Value	Description
11:8	RW	0x6	<p>usbphy_txvref_tune HS DC Voltage Level Adjustment Function: This bus adjusts the high-speed DC level voltage.</p> <p>1111: + 8.75% 1110: + 7.5% 1101: + 6.25% 1100: + 5% 1011: + 3.75% 1010: + 2.5% 1001: + 1.25% 1000: Design default 0111: -1.25% 0110: -2.5% 0101: -3.75% 0100: -5% 0011: -6.25% 0010: -7.5% 0001: -8.75% 0000: -10%</p>
7:4	RW	0xf	<p>usbphy_txfsls_tune FS/LS Source Impedance Adjustment Function: This bus adjusts the low- and full-speed single-ended source impedance while driving high. The following adjustment values are based on nominal process, voltage, and temperature.</p> <p>1111: -5% 0111: -2.5% 0011: Design default 0001: +2.5% 0000: +5%</p>
3	RW	0x1	<p>usbphy_txpreemppulse_tune HS Transmitter pre-emphasis duration control Function: This signal controls the duration for which the HS pre-emphasis current is sourced onto DP0 or DM0. transition in HS mode.</p> <p>1: 1X, short pre-emphasis current duration 0: (desian default) 2X, long pre-emphasis currrent duration</p>

Bit	Attr	Reset Value	Description
2:0	RW	0x3	usbphy_sqrxtune Squelch Threshold Adjustment Function: This bus adjusts the voltage level for the threshold used to detect valid high-speed data. 111: - 20% 110: -15% 101: -10% 100: -5% 011: Design default 010: + 5% 001: + 10% 000: + 15%

GRF_UOC0_CON2

Address: Operational Base + offset (0x0114)
otg control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15	RW	0x0	adpprbenn ADP probe signal 1: APD probe comparator is enabled 0: APD probe comparator is disabled
14	RW	0x0	adpdischrg VBUS input ADP discharge enable Control discharging the Vbus input during ADP 1: Enable discharging Vbus during ADP 0: disable discharging Vbus during ADP

Bit	Attr	Reset Value	Description
13	RW	0x0	adpchrg VBUS input ADP charge enable Control charging the Vbus input during ADP 1: Enable charging Vbus during ADP 0: Disable charging Vbus during ADP
12:11	RW	0x0	txrestune USB source impedance Adjustment 11:source impedance is decreased by 4ohm 10:source impedance is decreased by 2ohm 01:design default 00:source impedance is decreased by 1.5ohm
10	RW	0x0	sleepm sleep mode enable Asserting this signal place the USB 2.0 pico PHY in sleep mode. 0: sleep mode enable 1: normal mode
9	RO	0x0	reserved
8	RW	0x0	retenable retention mode enable 0: retention mode enable 1: retention mode disable
7:5	RW	0x0	fsel reference clock frequency select 111: 50MHz 110: Reserved 101: 24MHz 100: 20MHz 011: 19.2MHz 010: 12MHz 001: 10MHz 000: 9.6MHz
4:3	RW	0x0	usbphy_txpreempamp tune HS Transmitter Pre-Emphasis current control 11: 3X pre-emphasis current 10: 2X pre-emphasis current 01: 1X pre-emphasis current 00: HS Transmitter Pre-Emphasis is disabled
2	RW	0x0	usbphy_soft_con_sel 0: software control usb phy disable 1 : software control usb phy enable

Bit	Attr	Reset Value	Description
1	RW	0x0	<p>usbphy_vbus_vld_extsel External VBUS Valid Select Function: This signal selects the VBUSVLDEXT input or the internal Session Valid comparator to indicate when the VBUS signal on the USB cable is valid. 1: The VBUSVLDEXT input is used. 0: The internal Session Valid comparator is used.</p>
0	RW	0x0	<p>usbphy_vbus_vld_ext External VBUS Valid Indicator Function: This signal is valid in Device mode and only when the VBUSVLDEXTSEL signal is set to 1. VBUSVLDEXT indicates whether the VBUS signal on the USB cable is valid. In addition, BUSVLDEXT enables the pullup resistor on the D+ line. 1: The VBUS signal is valid, and the pull-up resistor on D+ is enabled. 0: The VBUS signal is not valid, and the pull-up resistor on D+ is disabled.</p>

GRF_UOC0_CON3

Address: Operational Base + offset (0x0118)

otg control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;</p>
15:6	RO	0x0	reserved

Bit	Attr	Reset Value	Description
5	RW	0x0	utmi_termselect USB termination select 1: full speed terminations are enabled 0: high speed terminations are enabled
4:3	RW	0x0	utmi_xcvrselect transceiver select 11: sends an LS packet on an FS bus or receives an LS packet 10: LS transceiver 01:FS transceiver 00: HS transceiver
2:1	RW	0x0	utmi_opmode utmi+ operational mode This controller bus selects the UTMI+ operation mode 11: normal operation without SYNC or EOP generation 10: disable bit stuffing and NRZI encoding 01: no-driving 00: normal
0	RW	0x0	utmi_suspend_n usb_phy suspend mode enable 1: normal operation mode 0: suspend mode

GRF_UOC1_CON0

Address: Operational Base + offset (0x011c)
usb host control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15	RW	0x1	<p>usbphy_txbitstuff_enh</p> <p>High-Byte Transmit Bit-Stuffing Enable</p> <p>Function: This controller signal controls bit stuffing on DATAINH[7:0] when OPMODE[1:0] = 2'b11.</p> <p>1: Bit stuffing is enabled.</p> <p>0: Bit stuffing is disabled.</p>
14	RW	0x1	<p>usbphy_txbitstuff_en</p> <p>Low-Byte Transmit Bit-Stuffing Enable</p> <p>Function: This controller signal controls bit stuffing on DATAINH[7:0] when OPMODE[1:0] = 2'b11.</p> <p>1: Bit stuffing is enabled.</p> <p>0: Bit stuffing is disabled.</p>
13	RW	0x0	<p>usbphy_siddq</p> <p>IDDQ Test Enable</p> <p>Function: This test signal enables you to perform IDDQ testing by powering down all analog blocks.</p> <p>1: The analog blocks are powered down.</p> <p>0: The analog blocks are powered up.</p>

Bit	Attr	Reset Value	Description
12	RW	0x0	<p>usbphy_port_reset Per-Port Reset Function: When asserted, this customer-specific signal resets the corresponding port transmit and receive logic without disabling the clocks within the USB 2. pico PHY.</p> <p>1: The transmit and receive finite state machines (FSMs) are reset, and the line_state logic combinatorially reflects the state of the single-ended receivers.</p> <p>0: The transmit and receive FSMs are operational, and the line_state logic becomes sequential after 11 PHYCLOCK cycles.</p>
11:10	RW	0x2	<p>usbphy_refclk_sel Reference Clock Select for PLL Block Function: This signal selects the reference clock source for the PLL block.</p> <p>11: Reserved 10: The PLL uses CLKCORE as reference. 01: The XO block uses an external, 1.8-V clock supplied on the XO pin. 00: The XO block uses the clock from a crystal.</p>
9	RW	0x0	<p>bypasssel transmitter digital bypass select 1: transmitter digital bypass mode is enabled 0: transmitter digital bypass mode is disabled</p>
8	RW	0x0	<p>bypassdmen DM0 transmitter digital bypass enable 1: DM0 FS/LS driver is enabled and driven with the BYPASSDPDATA0 signals 0: DM0 FS/LS driver is disabled in transmitter digital bypass mode</p>

Bit	Attr	Reset Value	Description
7:5	RW	0x3	<p>usbphy_otg_tune VBUS Valid Threshold Adjustment Function: This bus adjusts the voltage level for the VBUS Valid threshold.</p> <p>111: + 9% 110: + 6% 101: + 3% 100: Design default 011:- 3% 010:- 6% 001: - 9% 000: - 12%</p>
4	RW	0x0	<p>usbphy_otg_disable OTG Block Disable 1: the OTG block is power down 0: the OTG block is power up</p>
3:1	RW	0x1	<p>usbphy_compdistune Disconnect Threshold Adjustment Function: This bus adjusts the voltage level for the threshold used to detect a disconnect event at the host.</p> <p>111: + 4.5% 110: + 3% 101: + 1.5% 100: Design default 011: - 1.5% 010: - 3% 001: - 4.5% 000: - 6%</p>
0	RW	0x1	<p>usb_phy_common_on_n Common Block Power-Down Control Function: This signal controls the power-down signals in the XO, Bias, and PLL blocks when the USB 2.0 PHY is in Suspend or Sleep mode.</p> <p>1: In Suspend mode, the XO, Bias, and PLL blocks are powered down. In Sleep mode, the Bias and PLL blocks are powered down. 0: In Suspend mode, the XO, Bias, and PLL blocks remain powered in Suspend mode. In Sleep mode, if the reference clock is a crystal, the XO block remains powered.</p>

GRF_UOC1_CON1

Address: Operational Base + offset (0x0120)
usb host control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:14	RW	0x0	usbphy_txrise_tune HS Transmitter Rise/Fall Time Adjustment Function: This bus adjusts the rise/fall times of the high-speed waveform. 11: -20% 10: -15% 01: design default 00: +10%
13:12	RW	0x1	usbphy_txhsxv_tune Transmitter High-Speed Crossover Adjustment Function: This bus adjusts the voltage at which the DP and DM signals cross while transmitting in HS mode. 11: Default setting 10: + 15 mV 01: - 15 mV 00: Reserved

Bit	Attr	Reset Value	Description
11:8	RW	0x6	<p>usbphy_txvref_tune HS DC Voltage Level Adjustment Function: This bus adjusts the high-speed DC level voltage.</p> <p>1111: + 8.75% 1110: + 7.5% 1101: + 6.25% 1100: + 5% 1011: + 3.75% 1010: + 2.5% 1001: + 1.25% 1000: Design default 0111: -1.25% 0110: -2.5% 0101: - 3.75% 0100: - 5%</p>
7:4	RW	0xf	<p>usbphy_txfsls_tune FS/LS Source Impedance Adjustment Function: This bus adjusts the low- and full-speed single-ended source impedance while driving high. The following adjustment values are based on nominal process, voltage, and temperature.</p> <p>1111: - 5% 0111: -2.5% 0011: Design default 0001: + 2.5% 0000: + 5%</p>
3	RW	0x1	<p>usbphy_txfreemphasis_tune HS Transmitter Pre-Emphasis Enable Function: This signal controls the pre-emphasis for a J-K or K-J state transition in HS mode.</p> <p>1: The HS Transmitter pre-emphasis is enabled. 0 (design default): The HS Transmitter pre-emphasis is disabled</p>

Bit	Attr	Reset Value	Description
2:0	RW	0x3	usbphy_sqrxtune Squelch Threshold Adjustment Function: This bus adjusts the voltage level for the threshold used to detect valid high-speed data. 111: - 20% 110: -15% 101: -10% 100: -5% 011: Design default 010: + 5% 001: + 10% 000: + 15%

GRF_UOC1_CON2

Address: Operational Base + offset (0x0124)
otg control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15	RW	0x0	adpprbenn ADP probe signal 1: APD probe comparator is enabled 0: APD probe comparator is disabled
14	RW	0x0	adpdischrg VBUS input ADP discharge enable Control discharging the Vbus input during ADP 1: Enable discharging Vbus during ADP 0: disable discharging Vbus during ADP

Bit	Attr	Reset Value	Description
13	RW	0x0	adpchrg VBUS input ADP charge enable Control charging the Vbus input during ADP 1: Eanble charging Vbus during ADP 0: Disable charging Vbus buring ADP
12:11	RW	0x0	txrestune USB source impedance Adjustment 11:source impedance is desreased by 4ohm 10:source impedance is desreased by 2ohm 01:design default 00:source impedance is desreased by 1.5ohm
10	RW	0x0	sleepm Asserting this signal place the USB 2.0 pico PHY in sleep mode. 0: sleep mode enable 1: normal mode
9	RO	0x0	reserved
8	RW	0x0	retenable retention mode enable 0: retention mode enable 1: retention mode disable
7:5	RW	0x0	fsel reference clock frequency select 111: 50MHz 110: Reserved 101: 24MHz 100: 20MHz 011: 19.2MHz 010: 12MHz 001: 10MHz 000: 9.6MHz
4:3	RW	0x0	usbphy_txpreempampktune HS Transmitter Pre-Emphasis current control 11: 3X pre-emphasis current 10: 2X pre-emphasis current 01: 1X pre-emphasis current 00: HS Transmitter Pre-Emphasis is disabled
2	RW	0x0	usbphy_soft_con_sel 0: software control usb phy disable 1 : software control usb phy enable

Bit	Attr	Reset Value	Description
1	RW	0x0	<p>usbphy_vbus_vld_extsel External VBUS Valid Select Function: This signal selects the VBUSVLDEXT input or the internal Session Valid comparator to indicate when the VBUS signal on the USB cable is valid. 1: The VBUSVLDEXT input is used. 0: The internal Session Valid comparator is used.</p>
0	RW	0x0	<p>usbphy_vbus_vld_ext External VBUS Valid Indicator Function: This signal is valid in Device mode and only when the VBUSVLDEXTSEL signal is set to 1. VBUSVLDEXT indicates whether the VBUS signal on the USB cable is valid. In addition, VBUSVLDEXT enables the pullup resistor on the D+ line. 1: The VBUS signal is valid, and the pull-up resistor on D+ is enabled. 0: The VBUS signal is not valid, and the pull-up resistor on D+ is disabled.</p>

GRF_UOC1_CON3

Address: Operational Base + offset (0x0128)
usb host control register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;</p>
15:6	RO	0x0	reserved

Bit	Attr	Reset Value	Description
5	RW	0x0	utmi_termselect USB termination select 1: full speed terminations are enabled 0: high speed terminations are enabled
4:3	RW	0x0	utmi_xcvrselect transceiver select 11: sends an LS packet on an FS bus or receives an LS packet 10: LS transceiver 01:FS transceiver 00: HS transceiver
2:1	RW	0x0	utmi_opmode utmi+ operational mode This controller bus selects the UTMI+ operation mode 11: normal operation without SYNC or EOP generation 10: disable bit stuffing and NRZI encoding 01: no-driving 00: normal
0	RW	0x0	utmi_suspend_n usb_phy suspend mode enable 1: normal operation mode 0: suspend mode

GRF_OS_REG0

Address: Operational Base + offset (0x0144)

OS register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x0000	<p>os_reg</p> <p>software OS register</p>

GRF_OS_REG1

Address: Operational Base + offset (0x0148)
OS register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x0000	<p>os_reg</p> <p>software OS register</p>

GRF_OS_REG2

Address: Operational Base + offset (0x014c)
OS register

Bit	Attr	Reset Value	Description
31:16	WO	0x0000	write_enable bit0~bit15 write enable When bit 16=1, bit 0 can be written by software . When bit 16=0, bit 0 cannot be written by software; When bit 17=1, bit 1 can be written by software . When bit 17=0, bit 1 cannot be written by software; When bit 31=1, bit 15 can be written by software . When bit 31=0, bit 15 cannot be written by software;
15:0	RW	0x0000	os_reg software OS register

GRF_OS_REG3

Address: Operational Base + offset (0x0150)
OS register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	WO	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x0000	<p>os_reg</p> <p>software OS register</p>

GRF_OS_REG4

Address: Operational Base + offset (0x0154)

OS register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	os_reg OS register

GRF_OS_REG5

Address: Operational Base + offset (0x0158)

OS register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x0000	os_reg OS register

GRF_OS_REG6

Address: Operational Base + offset (0x015c)

OS register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x0000	<p>os_reg</p> <p>OS register</p>

GRF_OS_REG7

Address: Operational Base + offset (0x0160)
 OS register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>write_enable</p> <p>bit0~bit15 write enable</p> <p>When bit 16=1, bit 0 can be written by software .</p> <p>When bit 16=0, bit 0 cannot be written by software;</p> <p>When bit 17=1, bit 1 can be written by software .</p> <p>When bit 17=0, bit 1 cannot be written by software;</p> <p>.....</p> <p>When bit 31=1, bit 15 can be written by software .</p> <p>When bit 31=0, bit 15 cannot be written by software;</p>
15:0	RW	0x0000	<p>os_reg</p> <p>OS register</p>

Chapter 8 Embedded Processor: Cortex-A9

8.1 Overview

The Cortex™-A9 MP subsystem of the device is based on the symmetricmultiprocessor (SMP) architecture, thus the dual Cortex-A9 MPU subsystem delivers higher performanceand optimal power management, debug and emulation capabilities.

The Cortex-A9 MP subsystem incorporates two Cortex-A9 central processing units (CPUs), level 2(L2) cache shared between the two CPUs, and uses PL310 as L2 cache controller. Each CPU has 32KBof level 1 (L1) instruction cache, 32KB of L1 data cache, separate dedicated power domain, and includes one Neon™ and Vector Floating Point Unit (VFPv3) coprocessors. The Cortex-A9 MP subsystemalso includes standard CoreSight™ components to support SMP debug and emulation, snoop control unit(SCU), interrupt controller (GIC), and clock and reset manager.

The Cortex-A9 MP subsystem supports following feature:

- Coretex-A9 Processor
 - Cortex-A9 core revision r3p0
 - SMP architecture
 - Superscalar, variable length, out-of-order pipeline with dynamic branch prediction, 8-stage pipeline
 - Full implementation of the ARM architecture v7-A instruction setARM Neon Advanced SIMD (single instruction, multiple data) support for accelerated media andsignal processing computation.
 - Include VFPv3 hardware to support single and double-precision add, subtract, divide, multiply andaccumulate, and square root operations.
 - 32KB L1 instruction and 32KB L1 data cache – 32-byte line size, 4-way set associative
 - Memory management unit (MMU)
 - SCU ensures memory coherency between the two CPUs
 - Integrated timer and watchdog timer per CPU
 - Interrupt controller with 128 hardware interrupt inputs
- PL310 L2 cache controller (revision r3p2) with 256KB cache size
 - 8-way set associative
 - 32-byte line size
 - Two slave ports and two master ports
 - Includes four 256-bit line-fill-buffers (LFBs) shared by the master ports
 - Each slave port includes two 256-bit line-read-buffers (LRBs)
 - Includes four 256-bit store buffers with merge capability
 - Lockdown by line supported
 - Lockdown by master ID supported
 - Speculative Read supported
 - Address filter
- CoreSight
 - Program trace macrocell (PTM)
 - Emulation logic (cross-triggers)
 - TPIU and AMBA advanced trace bus (ATB) trace port

8.2 Block Diagram

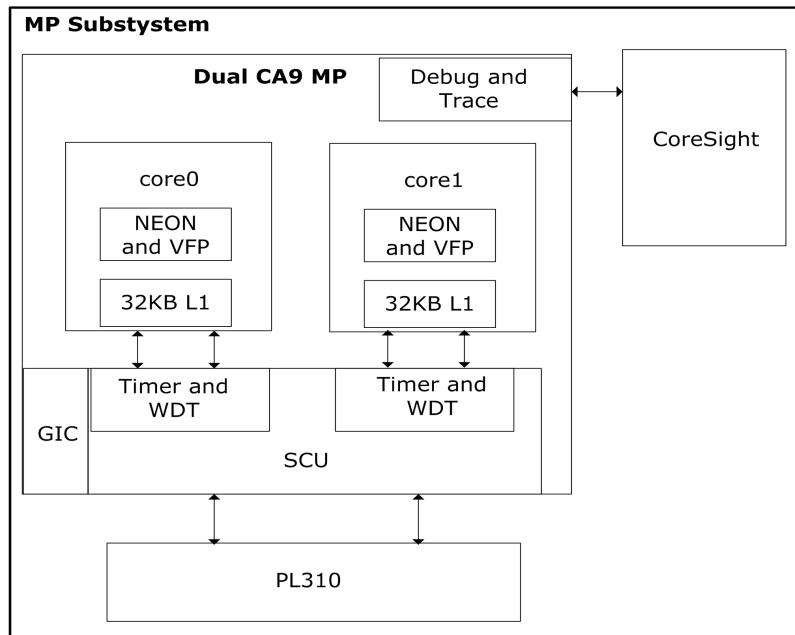


Fig. 8-1 MP Subsystem architecture

8.3 Function description

The SCU connects dual Cortex-A9 processors to the memory system through the AXI interfaces. The SCU functions are to maintain data cache coherency between the Cortex-A9 processors; initiate L2 AXI memory accesses; arbitrate between Cortex-A9 processors requesting L2 accesses.

The Interrupt Controller is compliant with the ARM Generic Interrupt Controller Architecture Specification 1.0. Please refer to Chapter 12 GIC.

The global timer is accessible to all Cortex-A9 processors in the cluster. Each Cortex-A9 processor has a private 64-bit comparator that is used to assert a private interrupt when the global timer has reached the comparator value. All the Cortex-A9 processors in a design use the banked ID, ID27, for this interrupt. ID27 is sent to the GIC as a Private Peripheral Interrupt. The global timer is a 64-bit incrementing counter with an auto-incrementing feature. It continues incrementing after sending interrupts.

The private timer and watchdog can only be accessed by the corresponding processor. It has a 32-bit counter that generates an interrupt when it reaches zero.

8.4 Register description

8.4.1 Registers Summary

Cortex-A9 MP SCU Registers Summary

Name	Offset	Size	Reset	Description
MP_SCU_CTRL	0x0000	W	0x00000000	Global timer counter low 32bits register
MP_SCU_CFG	0x0004	W	0x00000000	Global timer counter high 32bits register

Name	Offset	Size	Reset	Description
MP_SCU_PWR_STATUS	0x0008	W	0x00000000	Global timer control register
MP_SCU_INVALIDATE	0x000c	W	0x00000000	Global timer interrupt status register
MP_SCU_FILTER_START	0x0010	W	0x00000000	Global timer comparator low 32bits register
MP_SCU_FILTER_END	0x0014	W	0x00000000	Global timer comparator high 32bits register
MP_SCU_SAC	0x0018	W	0x00000000	Global timer auto increment register
MP_SCU_SNSAC	0x001c	W	0x00000000	Global timer auto increment register

Cortex-A9 MP Global Timer Registers Summary

Name	Offset	Size	Reset Value	Description
MP_GTIMER_COUNTER_LOW	0x0000	W	0x00000000	Global timer counter low 32bits register
MP_GTIMER_COUNTER_HIGH	0x0004	W	0x00000000	Global timer counter high 32bits register
MP_GTIMER_CONTROL	0x0008	W	0x00000000	Global timer control register
MP_GTIMER_INT_STATUS	0x000c	W	0x00000000	Global timer interrupt status register
MP_GTIMER_COMPARE_LOW	0x0010	W	0x00000000	Global timer comparator low 32bits register
MP_GTIMER_COMPARE_HIGH	0x0014	W	0x00000000	Global timer comparator high 32bits register
MP_GTIMER_AUTO_INCR	0x0018	W	0x00000000	Global timer auto increment register

Cortex-A9 MP Private Timer Registers Summary

Name	Offset	Size	Reset Value	Description
MP_PTIMER_TIMER_LOAD	0x0000	W	0x00000000	Private timer load register
MP_PTIMER_TIMER_COUNTER	0x0004	W	0x00000000	Private timer counter register

Name	Offset	Size	Reset Value	Description
MP_PTIMER_TIMER_CONTROL	0x0008	W	0x00000000	Private timer control register
MP_PTIMER_TIMER_INT_STATUS	0x000c	W	0x00000000	Private timer interrupt status register
MP_PTIMER_WDT_LOAD	0x0020	W	0x00000000	Private watchdogload register
MP_PTIMER_WDT_COUNTER	0x0024	W	0x00000000	Private watchdog counter register
MP_PTIMER_WDT_CONTROL	0x0028	W	0x00000000	Private watchdog control register
MP_PTIMER_WDT_INT_STATUS	0x002c	W	0x00000000	Private watchdog interrupt status register
MP_PTIMER_WDT_RESET_STATUS	0x0030	W	0x00000000	Private watchdog reset status register
MP_PTIMER_WDT_DISABLE	0x0034	W	0x00000000	private watchdog disable

L2C Registers Summary

Name	Offset	Size	Reset Value	Description
L2C_reg0_cache_id	0x0000	W	0x410000c6	Cache ID Register
L2C_reg0_cache_type	0x0004	W	0x00000000	Cache Type Register
L2C_reg1_control	0x0100	W	0x00000000	
L2C_reg1_aux_control	0x0104	W	0x00000000	Auxiliary Control Register
L2C_reg1_tag_ram_control	0x0108	W	0x00000000	Tag RAM Latency Control Registers
L2C_reg1_data_ram_control	0x010c	W	0x00000000	Data RAM Latency Control Registers
L2C_reg2_ev_counter_ctrl	0x0200	W	0x00000000	Event Counter Control Register

Name	Offset	Size	Reset Value	Description
L2C_reg2_ev_counter1_cfg	0x0204	W	0x00000000	Event Counter Configuration Registers
L2C_reg2_ev_counter0_cfg	0x0208	W	0x00000000	Event Counter Configuration Registers
L2C_reg2_ev_counter1	0x020c	W	0x00000000	Event counter value registers
L2C_reg2_ev_counter0	0x0210	W	0x00000000	Event counter value registers
L2C_reg2_int_mask	0x0214	W	0x00000000	
L2C_reg2_int_mask_status	0x0218	W	0x00000000	
L2C_reg2_int_raw_status	0x021c	W	0x00000000	
L2C_reg2_int_clear	0x0220	W	0x00000000	
L2C_reg7_cache_sync	0x0730	W	0x00000000	
L2C_reg7_inv_pa	0x0770	W	0x00000000	
L2C_reg7_inv_way	0x077c	W	0x00000000	
L2C_reg7_clean_pa	0x07b0	W	0x00000000	
L2C_reg7_clean_index	0x07b8	W	0x00000000	
L2C_reg7_clean_way	0x07bc	W	0x00000000	
L2C_reg7_clean_inv_pa	0x07f0	W	0x00000000	
L2C_reg7_clean_inv_index	0x07f8	W	0x00000000	
L2C_reg7_clean_inv_way	0x07fc	W	0x00000000	
L2C_reg9_d_lockdown0	0x0900	W	0x00000000	
L2C_reg9_i_lockdown0	0x0904	W	0x00000000	
L2C_reg9_d_lockdown1	0x0908	W	0x00000000	
L2C_reg9_i_lockdown1	0x090c	W	0x00000000	
L2C_reg9_d_lockdown2	0x0910	W	0x00000000	
L2C_reg9_i_lockdown2	0x0914	W	0x00000000	
L2C_reg9_d_lockdown3	0x0918	W	0x00000000	
L2C_reg9_i_lockdwon3	0x091c	W	0x00000000	
L2C_reg9_d_lockdown4	0x0920	W	0x00000000	
L2C_reg9_i_lockdwon4	0x0924	W	0x00000000	
L2C_reg9_d_lockdwon5	0x0928	W	0x00000000	
L2C_reg9_i_lockdwon5	0x092c	W	0x00000000	
L2C_reg9_d_lockdwon6	0x0930	W	0x00000000	
L2C_reg9_i_lockdwon6	0x0934	W	0x00000000	
L2C_reg9_d_lockdwon7	0x0938	W	0x00000000	
L2C_reg9_i_lockdwon7	0x093c	W	0x00000000	
L2C_reg9_lock_line_en	0x0950	W	0x00000000	

Name	Offset	Size	Reset Value	Description
L2C_reg9_unlock_way	0x0954	W	0x00000000	
L2C_reg12_addr_filtering_start	0x0c00	W	0x00000000	
L2C_reg12_addr_filtering_end	0x0c04	W	0x00000000	
L2C_reg15_debug_ctrl	0x0f40	W	0x00000000	Debug Register 0
L2C_reg15_prefetch_ctrl	0x0f60	W	0x00000000	Prefetch Control Register
L2C_reg15_power_ctrl	0x0f80	W	0x00000000	Power Control Register

8.4.2 Detail Registers Description

MP_SCU_CTRL

Address: Operational Base + offset (0x0000)

SCU Control Register

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6	RW	0x0	ic_standby_en when set, this stops the Interrupt Controller clock when no interrupts are pending, and no CPU is performing a read/write request.
5	RW	0x0	scu_stanby_en When set, SCU CLK is turned off when all processors are in WFI mode, and there is no remaining activity in the SCU. The clock is turned on when any processor leaves WFI mode.
4	RW	0x0	force all device to port0 enable When set, all requests from processors with AxCACHE = NonCacheable Bufferable are forced to be issued on the AXI Master port M0.
3	RW	0x0	scu speculative linefills enable When set, coherent linefill requests are sent speculatively to the L2C-310 in parallel with the tag look-up. If the tag look-up misses, the confirmed linefill is sent to the L2C-310 and gets RDATA earlier because the data request was already initiated by the speculative request. This feature works only if the L2C-310 is present in the design.

Bit	Attr	Reset Value	Description
2	RW	0x0	scu rams parity enable 1 = Parity on. 0 = Parity off. This is the default setting. This bit is always zero if support for parity is not implemented.
1	RW	0x0	address filtering enable 1 = Addressing filtering on. 0 = Addressing filtering off. The default value is the value of FILTEREN sampled when nSCURESET is deasserted.
0	RW	0x0	1 = SCU enable. 0 = SCU disable. This is the default setting.

MP_SCU_CFG

Address: Operational Base + offset (0x0004)

SCU Configuration Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:8	RW	0x00	tagram_size Bits [11:10] indicate Cortex-A9 processor CPU1 tag RAM size if present. Bits [9:8] indicate Cortex-A9 processor CPU0 tag RAM size. The encoding is as follows: b11 = reserved b10 = 64KB cache, 256 indexes per tag RAM b01 = 32KB cache, 128 indexes per tag RAM b00 = 16KB cache, 64 indexes per tag RAM.
7:4	RW	0x0	cpus_smp 0 = this Cortex-A9 processor is in AMP mode not taking part in coherency or not present. 1 = this Cortex-A9 processor is in SMP mode taking part in coherency. Bit 5 is for CPU1 Bit 4 is for CPU0.
3:2	RO	0x0	reserved
1:0	RW	0x0	cpu_numbers Number of CPUs present in the Cortex-A9 MPCore processor b01 = two Cortex-A9 processors, CPU0 and CPU1 b00 = one Cortex-A9 processor, CPU0.

MP_SCU_PWR_STATUS

Address: Operational Base + offset (0x0008)
 SCU CPU Power Status Register

Bit	Attr	Reset Value	Description
31:10	RO	0x0	reserved
9:8	RW	0x0	cpu1_status Power status of the Cortex-A9 processor.
7:2	RO	0x0	reserved
1:0	RW	0x0	cpu0_status Power status of the Cortex-A9 processor.

MP_SCU_INVALIDATE

Address: Operational Base + offset (0x000c)
 SCU Invalidate All Registers

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
7:4	RW	0x0	cpu1_ways Specifies the ways that must be invalidated for CPU1. Writing to these bits has no effect if the Cortex-A9 MPCore processor has fewer than two processors.
3:0	RW	0x0	cpu0_ways Specifies the ways that must be invalidated for CPU0.

MP_SCU_FILTER_START

Address: Operational Base + offset (0x0010)
 Filtering Start Address Register

Bit	Attr	Reset Value	Description
31:20	RW	0x000	filter start address Start address for use with master port 1 in a two-master port configuration when address filtering is enabled. The default value is the value of FILTERSTART sampled on exit from reset. The value on the pin gives the upper address bits with 1MB granularity.
19:0	RO	0x000	reserved

MP_SCU_FILTER_END

Address: Operational Base + offset (0x0014)
 Filtering End Address Register

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:20	RW	0x000	filter end address End address for use with master port 1 in a two-master port configuration, when address filtering is enabled. The default value is the value of FILTEREND sampled on exit from reset. The value on the pin gives the upper address bits with 1MB granularity.
19:0	RO	0x000	reserved

MP_SCU_SAC

Address: Operational Base + offset (0x0018)

SCU Access Control Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3	RW	0x0	cpu3 access Field0002 Description
2	RW	0x0	cpu2 access Field0001 Description
1	RW	0x0	cpu1 access 0 = CPU1 cannot access the components. 1 = CPU1 can access the components. This is the default.
0	RW	0x0	cpu0 access 0 = CPU0 cannot access the components. 1 = CPU0 can access the components. This is the default.

MP_SCU_SNSAC

Address: Operational Base + offset (0x001c)

SCU Non-secure Access Control Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:8	RW	0x0	global access control for CPU<n> Non-secure access to the global timer for CPU<n>. <n> is 1 for bit[1] <n> is 0 for bit[0]. 0 = Secure accesses only. This is the default value. 1 = Secure accesses and Non-Secure accesses.

Bit	Attr	Reset Value	Description
7:4	RW	0x0	private access controll for CPU<n> Non-secure access to the private timer and watchdog for CPU<n>. <n> is 1 for bit[1] <n> is 0 for bit[0]. 0 = Secure accesses only. Non-secure reads return 0. This is the default value. 1 = Secure accesses and Non-secure accesses.
3:0	RW	0x0	component access control for CPU<n> Non-secure access to the components for CPU<n>. <n> is 1 for bit[1] <n> is 0 for bit[0]. 0 = CPU cannot write the components 1 = CPU can access the components.

MP_GTIMER_COUNTER_LOW

Address: Operational Base + offset (0x0000)

Global timer counter low 32bits register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	load lower 32-bit timer counter register

MP_GTIMER_COUNTER_HIGH

Address: Operational Base + offset (0x0004)

Global timer counter high 32bits register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	counter upper 32-bit timer counter register

MP_GTIMER_CONTROL

Address: Operational Base + offset (0x0008)

Global timer control register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:8	RW	0x00	prescaler The prescaler modifies the clock period for the decrementing event for the Counter Register.
7:4	RO	0x0	reserved

Bit	Attr	Reset Value	Description
3	RW	0x0	<p>auto increment This bit is banked per Cortex-A9 processor. 1'b0: single shot mode. When the counter reaches the comparator value, sets the event flag. It is the responsibility of software to update the comparator value to get further events. 1'b1: auto increment mode. Each time the counter reaches the comparator value, the comparator register is incremented with the auto-increment register, so that further events can be set periodically without any software updates.</p>
2	RW	0x0	<p>IRQ enable This bit is banked per Cortex-A9 processor. If set, the interrupt ID 27 is set as pending in the Interrupt Distributor when the event flag is set in the Timer Status Register</p>
1	RW	0x0	<p>compare enable This bit is banked per Cortex-A9 processor. If set, it allows the comparison between the 64-bit Timer Counter and the related 64-bit Comparator Register.</p>
0	RW	0x0	<p>Timer enable 1'b0 = Timer is disabled and the counter does not increment. All registers can still be read and written 1'b1 = Timer is enabled and the counter increments normally</p>

MP_GTIMER_INT_STATUS

Address: Operational Base + offset (0x000c)

Global timer interrupt status register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved

Bit	Attr	Reset Value	Description
0	RW	0x0	<p>event flag</p> <p>This is a banked register for all Cortex-A9 processors present.</p> <p>The event flag is a sticky bit that is automatically set when the Counter Register reaches the Comparator Register value. If the timer interrupt is enabled, Interrupt ID 27 is set as pending in the Interrupt Distributor after the event flag is set. The event flag is cleared when written to 1.</p>

MP_GTIMER_COMPARE_LOW

Address: Operational Base + offset (0x0010)
Global timer comparator low 32bits register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	lower 32-bit Comparator Value Register

MP_GTIMER_COMPARE_HIGH

Address: Operational Base + offset (0x0014)
Global timer comparator high 32bits register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	upper 32-bit Comparator Value Register

MP_GTIMER_AUTO_INCR

Address: Operational Base + offset (0x0018)
Global timer auto increment register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	<p>Autoincrement</p> <p>This 32-bit register gives the increment value of the Comparator Register when the Auto-increment bit is set in the Timer Control Register. Each Cortex-A9 processor present has its own Auto-increment Register.</p> <p>If the comp enable and auto-increment bits are set when the global counter reaches the Comparator Register value, the comparator is incremented by the auto-increment value, so that a new event can be set periodically.</p> <p>The global timer is not affected and goes on incrementing.</p>

MP_PTIMER_TIMER_LOAD

Address: Operational Base + offset (0x0000)

Private timer load register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	The Timer Load Register contains the value copied to the Timer Counter Register when it decrements down to zero with auto reload mode enabled. Writing to the Timer Load Register means that you also write to the Timer Counter Register.

MP_PTIMER_TIMER_COUNTER

Address: Operational Base + offset (0x0004)

Private timer counter register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	counter

MP_PTIMER_TIMER_CONTROL

Address: Operational Base + offset (0x0008)

Private timer control register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:8	RW	0x00	prescaler The prescaler modifies the clock period for the decrementing event for the Counter Register.
7:3	RO	0x0	reserved
2	RW	0x0	IRQ enable If set, the interrupt ID 29 is set as pending in the Interrupt Distributor when the event flag is set in the Timer Status Register
1	RW	0x0	auto reload 1'b0 = Single shot mode. Counter decrements down to zero, sets the event flag and stops. 1'b1 = Auto-reload mode. Each time the Counter Register reaches zero, it is reloaded with the value contained in the Timer Load Register.
0	RW	0x0	Timer enable 1'b0 = Timer is disabled and the counter does not decrement. All registers can still be read and written 1'b1 = Timer is enabled and the counter decrements normally

MP_PTIMER_TIMER_INT_STATUS

Address: Operational Base + offset (0x000c)

Private timer interrupt status register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	event flag The event flag is a sticky bit that is automatically set when the Counter Register reaches zero. If the timer interrupt is enabled, Interrupt ID 29 is set as pending in the Interrupt Distributor after the event flag is set. The event flag is cleared when written to 1.

MP_PTIMER_WDT_LOAD

Address: Operational Base + offset (0x0020)

Private watchdogload register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	The Watchdog Load Register contains the value copied to the Watchdog Counter Register when it decrements down to zero with auto reload mode enabled, in Timer mode. Writing to the Watchdog Load Register means that you also write to the Watchdog Counter Register

MP_PTIMER_WDT_COUNTER

Address: Operational Base + offset (0x0024)

Private watchdog counter register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	It decrements if the Watchdog is enabled using the Watchdog enable bit in the Watchdog Control Register.

MP_PTIMER_WDT_CONTROL

Address: Operational Base + offset (0x0028)

Private watchdog control register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:8	RW	0x00	The prescaler modifies the clock period for the decrementing event for the Counter Register.
7:4	RO	0x0	reserved

Bit	Attr	Reset Value	Description
3	RW	0x0	watchdog mode 1'b0 = Timer mode, default Writing a zero to this bit has no effect. You must use the Watchdog Disable Register to put the watchdog into timer mode. 1'b1 = Watchdog mode
2	RW	0x0	IT enable If set, the interrupt ID 30 is set as pending in the Interrupt Distributor when the event flag is set in the watchdog Status Register. In watchdog mode this bit is ignored
1	RW	0x0	auto reload 1'b0 = Single shot mode. Counter decrements down to zero, sets the event flag and stops. 1'b1 = Auto-reload mode. Each time the Counter Register reaches zero, it is reloaded with the value contained in the Load Register and then continues decrementing.
0	RW	0x0	watchdog enable Global watchdog enable 1'b0 = Watchdog is disabled and the counter does not decrement. All registers can still be read and /or written 1'b1 = Watchdog is enabled and the counter decrements normally

MP_PTIMER_WDT_INT_STATUS

Address: Operational Base + offset (0x002c)

Private watchdog interrupt status register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	event flag The event flag is a sticky bit that is automatically set when the Counter Register reaches zero in timer mode. If the watchdog interrupt is enabled, Interrupt ID 30 is set as pending in the Interrupt Distributor after the event flag is set. The event flag is cleared when written with a value of 1. Trying to write a zero to the event flag or a one when it is not set has no effect.

MP_PTIMER_WDT_RESET_STATUS

Address: Operational Base + offset (0x0030)

Private watchdog reset status register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	private watchdog reset flag The reset flag is a sticky bit that is automatically set when the Counter Register reaches zero and a reset request is sent accordingly. (In watchdog mode)

MP_PTIMER_WDT_DISABLE

Address: Operational Base + offset (0x0034)

private watchdog disable

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	WO	0x0	private watchdog disable Use the Watchdog Disable Register to switch from watchdog to timer mode. The software must write 0x12345678 then 0x87654321 successively to the Watchdog Disable Register so that the watchdog mode bit in the Watchdog Control Register is set to zero.

L2C_reg0_cache_id

Address: Operational Base + offset (0x0000)

Cache ID Register

Bit	Attr	Reset Value	Description
31:24	RW	0x41	Implementer
23:16	RO	0x0	reserved
15:10	RW	0x00	CacheID
9:6	RW	0x3	PartNumber
5:0	RW	0x06	RTL release

L2C_reg0_cache_type

Address: Operational Base + offset (0x0004)

Cache Type Register

Bit	Attr	Reset Value	Description
31	RW	0x0	data_banking 0 = Data banking not implemented. 1 = Data banking implemented
30:29	RO	0x0	reserved

Bit	Attr	Reset Value	Description
28:25	RW	0x0	ctype 11xy, where: x=1 if pl310_LOCKDOWN_BY_MASTER is defined, otherwise 0 y=1 if pl310_LOCKDOWN_BY_LINE is defined, otherwise 0.
24:12	RO	0x0	reserved
11:7	RW	0x00	Isize Read from Auxiliary Control Register[19:17]
6	RW	0x0	associativity Read from Auxiliary Control Register[16]
5:2	RO	0x0	reserved
1:0	RW	0x0	line_length 00-32 bytes

L2C_reg1_control

Address: Operational Base + offset (0x0100)
reg1_control

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	I2_en 0 = L2 Cache is disabled. This is the default value. 1 = L2 Cache is enabled

L2C_reg1_aux_control

Address: Operational Base + offset (0x0104)
Auxiliary Control Register

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved
30	RW	0x0	early_bresp_en 0 = Early BRESP disabled. This is the default. 1 = Early BRESP enabled.
29	RW	0x0	inst_prf_en 0 = Instruction prefetching disabled. This is the default. 1 = Instruction prefetching enabled.
28	RW	0x0	data_prf_en 0 = Data prefetching disabled. This is the default. 1 = Data prefetching enabled

Bit	Attr	Reset Value	Description
27	RW	0x0	ns_int_ac 0 = Interrupt Clear, 0x220, and Interrupt Mask, 0x214, can only be modified or read with secure accesses. This is the default. 1 = Interrupt Clear, 0x220, and Interrupt Mask, 0x214, can be modified or read with secure or non-secure accesses.
26	RW	0x0	ns_lock_en 0 = Lockdown registers cannot be modified using non-secure accesses. This is the default. 1 = Non-secure accesses can write to the lockdown registers.
25	RW	0x0	crp 0 = pseudo-random replacement using Ifsr. 1 = round-robin replacement. This is the default.
24:23	RW	0x0	fwa b00 = Use AWCACHE attributes for WA. This is the default. b01 = Force no allocate, set WA bit always 0. b10 = Override AWCACHE attributes, set WA bit always 1, all cacheable write misses become write allocated. b11 = Internally mapped to 00.
22	RW	0x0	sav_en 0 = Treats shared accesses as specified in Shareable attribute. This is the default. 1 = Shared attribute internally ignored.
21	RW	0x0	parity_en 0 = Disabled. This is the default. 1 = Enabled
20	RW	0x0	evmb_en 0 = Disabled. This is the default. 1 = Enable

Bit	Attr	Reset Value	Description
19:17	RW	0x0	<p>way_size</p> <p>b000 = Reserved, internally mapped to 16KB.</p> <p>b001 = 16KB.</p> <p>b010 = 32KB.</p> <p>b011 = 64KB.</p> <p>b100 = 128KB.</p> <p>b101 = 256KB.</p> <p>b110 = 512KB.</p> <p>b111 = Reserved, internally mapped to 512 KB.</p>
16	RW	0x0	<p>associativity</p> <p>0 = 8-way.</p> <p>1 = 16-way.</p>
15:14	RO	0x0	reserved
13	RW	0x0	<p>sai_en</p> <p>0 = Shared invalidate behavior disabled. This is the default.</p> <p>1 = Shared invalidate behavior enabled, if Shared Attribute Override Enable bit not set.</p>
12	RW	0x0	<p>excc</p> <p>0 = Disabled. This is the default.</p> <p>1 = Enabled,</p>
11	RW	0x0	<p>sndl_en</p> <p>0 = Store buffer device limitation disabled. Device writes can take all slots in store buffer. This is the default.</p> <p>1= Store buffer device limitation enabled. Device writes cannot take all slots in store buffer when connected to the Cortex-A9 MPCore processor. There is always one available slot to service Normal Memory</p>
10	RO	0x0	<p>stronly_priority</p> <p>0 = Strongly Ordered and Device reads have lower priority than cacheable accesses when arbitrated in the L2CC (L2C-310) master ports. This is the default.</p> <p>1 = Strongly Ordered and Device reads get the highest priority when arbitrated in the L2CC (L2C-310) master ports.</p>
9:1	RO	0x0	reserved

Bit	Attr	Reset Value	Description
0	RO	0x0	full_line_zero 0 = Full line of write zero behavior disabled. This is the default. 1 = Full line of write zero behavior Enabled

L2C_reg1_tag_ram_control

Address: Operational Base + offset (0x0108)

Tag RAM Latency Control Registers

Bit	Attr	Reset Value	Description
31:11	RO	0x0	reserved
10:8	RW	0x0	write_ac_latency b000 = 1 cycle of latency, there is no additional latency. b001 = 2 cycles of latency. b010 = 3 cycles of latency. b011 = 4 cycles of latency. b100 = 5 cycles of latency. b101 = 6 cycles of latency. b110 = 7 cycles of latency. b111 = 8 cycles of latency.
7	RO	0x0	reserved
6:4	WO	0x0	read_ac_latency b000 = 1 cycle of latency, there is no additional latency. b001 = 2 cycles of latency. b010 = 3 cycles of latency. b011 = 4 cycles of latency. b100 = 5 cycles of latency. b101 = 6 cycles of latency. b110 = 7 cycles of latency. b111 = 8 cycles of latency
3	RO	0x0	reserved
2:0	WO	0x0	setup_latency b000 = 1 cycle of latency, there is no additional latency. b001 = 2 cycles of latency. b010 = 3 cycles of latency. b011 = 4 cycles of latency. b100 = 5 cycles of latency. b101 = 6 cycles of latency. b110 = 7 cycles of latency. b111 = 8 cycles of latency.

L2C_reg1_data_ram_control

Address: Operational Base + offset (0x010c)

Data RAM Latency Control Registers

Bit	Attr	Reset Value	Description
31:11	RO	0x0	reserved
10:8	RW	0x0	write_ac_latency b000 = 1 cycle of latency, there is no additional latency. b001 = 2 cycles of latency. b010 = 3 cycles of latency. b011 = 4 cycles of latency. b100 = 5 cycles of latency. b101 = 6 cycles of latency. b110 = 7 cycles of latency. b111 = 8 cycles of latency.
7	RO	0x0	reserved
6:4	RW	0x0	read_ac_latency b000 = 1 cycle of latency, there is no additional latency. b001 = 2 cycles of latency. b010 = 3 cycles of latency. b011 = 4 cycles of latency. b100 = 5 cycles of latency. b101 = 6 cycles of latency. b110 = 7 cycles of latency. b111 = 8 cycles of latency.
3	RO	0x0	reserved
2:0	RO	0x0	setup_latency b000 = 1 cycle of latency, there is no additional latency. b001 = 2 cycles of latency. b010 = 3 cycles of latency. b011 = 4 cycles of latency. b100 = 5 cycles of latency. b101 = 6 cycles of latency. b110 = 7 cycles of latency. b111 = 8 cycles of latency.

L2C_reg2_ev_counter_ctrl

Address: Operational Base + offset (0x0200)

Event Counter Control Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved

Bit	Attr	Reset Value	Description
2:1	RO	0x0	<p>counter_rst Always Read as zero. The following counters are reset when a 1 is written to the following bits:</p> <p>bit[2] = Event Counter1 reset bit[1] = Event Counter0 reset.</p>
0	RO	0x0	<p>ev_cnt_en 0 = Event Counting Disable. This is the default. 1 = Event Counting Enable</p>

L2C_reg2_ev_counter1_cfg

Address: Operational Base + offset (0x0204)

Event Counter Configuration Registers

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:2	RW	0x0	ev_source
1:0	RW	0x0	<p>ev_cnt_int_gen b00 = Disabled. This is the default. b01 = Enabled: Increment condition. b10 = Enabled: Overflow condition. b11 = Interrupt generation is disabled</p>

L2C_reg2_ev_counter0_cfg

Address: Operational Base + offset (0x0208)

Event Counter Configuration Registers

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:2	RW	0x0	en_source
1:0	RO	0x0	ev_cnt_int_gen

L2C_reg2_ev_counter1

Address: Operational Base + offset (0x020c)

Event counter value registers

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	<p>cnt_val Total of the event selected. If a counter reaches its maximum value, it saturates at that value until it is reset.</p>

L2C_reg2_ev_counter0

Address: Operational Base + offset (0x0210)

Event counter value registers

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	cnt_val Total of the event selected. If a counter reaches its maximum value, it saturates at that value until it is reset.

L2C_reg2_int_mask

Address: Operational Base + offset (0x0214)

reg2_int_mask

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8	RW	0x0	DECERR_MSK 1 = Enabled. 0 = Masked. This is the default.
7	RW	0x0	SLVERR_MSK 1 = Enabled. 0 = Masked. This is the default.
6	RW	0x0	ERRRD_MSK 1 = Enabled. 0 = Masked. This is the default.
5	RW	0x0	ERRRT_MSK 1 = Enabled. 0 = Masked. This is the default.
4	RW	0x0	ERRWD_MSK 1 = Enabled. 0 = Masked. This is the default.
3	RW	0x0	ERRWT_MSK 1 = Enabled. 0 = Masked. This is the default.
2	RW	0x0	PARRD_MSK 1 = Enabled. 0 = Masked. This is the default.
1	RW	0x0	PARRT_MSK 1 = Enabled. 0 = Masked. This is the default.
0	RO	0x0	ECNTR_MSK 1 = Enabled. 0 = Masked. This is the default.

L2C_reg2_int_mask_status

Address: Operational Base + offset (0x0218)

reg2_int_mask_status

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8	RW	0x0	DECERR_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the inputlines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked
7	RW	0x0	SLVERR_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked
6	RW	0x0	ERRRD_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked
5	RW	0x0	ERRRT_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked
4	RW	0x0	ERRWD_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked
3	RW	0x0	ERRWT_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked

Bit	Attr	Reset Value	Description
2	RW	0x0	PARRD_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked
1	RW	0x0	PARRT_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked
0	RO	0x0	ECNTR_MSKST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, either no interrupt has been generated, or the interrupt is masked

L2C_reg2_int_raw_status

Address: Operational Base + offset (0x021c)
reg2_int_raw_status

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8	RW	0x0	DECERR_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.
7	RW	0x0	SLVERR_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.
6	RW	0x0	ERRRD_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.

Bit	Attr	Reset Value	Description
5	RW	0x0	ERRRT_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.
4	RW	0x0	ERRWD_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.
3	RW	0x0	ERRWT_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.
2	RW	0x0	PARRD_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.
1	RW	0x0	PARRT_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.
0	RO	0x0	ECNTR_RAWST Bits read can be HIGH or LOW: HIGH If the bits read HIGH, they reflect the status of the input lines triggering an interrupt. LOW If the bits read LOW, no interrupt has been generated.

L2C_reg2_int_clear

Address: Operational Base + offset (0x0220)
 reg2_int_clear

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved

Bit	Attr	Reset Value	Description
8	RW	0x0	<p>DECERR_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>
7	RW	0x0	<p>SLVERR_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>
6	RW	0x0	<p>ERRRD_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>
5	RW	0x0	<p>ERRRT_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>
4	RW	0x0	<p>ERRWD_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>
3	RW	0x0	<p>ERRWT_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>
2	RW	0x0	<p>PARRD_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>
1	RW	0x0	<p>PARRT_CL</p> <p>When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register.</p> <p>When a bit is written as 0, it has no effect</p>

Bit	Attr	Reset Value	Description
0	RO	0x0	ECNTR_CL When a bit is written as 1, it clears the corresponding bit in the Raw Interrupt Status Register. When a bit is written as 0, it has no effect

L2C_reg7_cache_sync

Address: Operational Base + offset (0x0730)

reg7_cache_sync

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	sync Drain the STB. Operation complete when all buffers, LRB, LFB, STB, and EB, are empty

L2C_reg7_inv_pa

Address: Operational Base + offset (0x0770)

reg7_inv_pa

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	set_en Specific L2 cache line is marked as not valid.

L2C_reg7_inv_way

Address: Operational Base + offset (0x077c)

reg7_inv_way

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	Invalidate all data in specified ways, including dirty data. An Invalidate by way while selecting all cache ways is equivalent to invalidating all cache entries. Completes as a background task with the way, or ways, locked, preventing allocation.

L2C_reg7_clean_pa

Address: Operational Base + offset (0x07b0)

reg7_clean_pa

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	set_en set enable bits Write the specific L2 cache line to L3 main memory if the line is marked as valid and dirty. The line is marked as not dirty. The valid bit is unchanged.

L2C_reg7_clean_index

Address: Operational Base + offset (0x07b8)

reg7_clean_index

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	set_en set enable bits Write the specific L2 cache line within the specified way to L3 main memory if the line is marked as valid and dirty. The line is marked as not dirty. The valid bit is unchanged

L2C_reg7_clean_way

Address: Operational Base + offset (0x07bc)

reg7_clean_way

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	clear_en clear enable bits Writes each line of the specified L2 cache ways to L3 main memory if the line is marked as valid and dirty. The lines are marked as not dirty. The valid bits are unchanged. Completes as a background task with the way, or ways, locked, preventing allocation

L2C_reg7_clean_inv_pa

Address: Operational Base + offset (0x07f0)

reg7_clean_inv_pa

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	clear_en clear enable bits Write the specific L2 cache line to L3 main memory if the line is marked as valid and dirty. The line is marked as not valid.

L2C_reg7_clean_inv_index

Address: Operational Base + offset (0x07f8)

reg7_clean_inv_index

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	clear_en Write the specific L2 cache line within the specified way to L3 main memory if the line is marked as valid and dirty. The line is marked as not valid

L2C_reg7_clean_inv_way

Address: Operational Base + offset (0x07fc)

reg7_clean_inv_way

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	clear_en Writes each line of the specified L2 cache ways to L3 main memory if the line is marked as valid and dirty. The lines are marked as not valid. Completes as a background task with the way, or ways, locked, preventing allocation.

L2C_reg9_d_lockdown0

Address: Operational Base + offset (0x0900)

reg9_d_lockdown0

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	datalog000 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_i_lockdown0

Address: Operational Base + offset (0x0904)

reg9_i_lockdown0

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	instlock000 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_d_lockdown1

Address: Operational Base + offset (0x0908)

reg9_d_lockdown1

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	datalock001 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg_i_lockdown1

Address: Operational Base + offset (0x090c)

reg_i_lockdown1

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	instlock001 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_d_lockdown2

Address: Operational Base + offset (0x0910)

reg9_d_lockdown2

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	datalock002 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_i_lockdown2

Address: Operational Base + offset (0x0914)

reg9_i_lockdown2

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	instlock002 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_d_lockdown3

Address: Operational Base + offset (0x0918)

reg9_d_lockdown3

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	datalock003 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_i_lockdwon3

Address: Operational Base + offset (0x091c)

reg9_i_lockdwon3

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	instlock003 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_d_lockdown4

Address: Operational Base + offset (0x0920)

reg9_d_lockdown4

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	datalock004 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_i_lockdwon4

Address: Operational Base + offset (0x0924)

reg9_i_lockdwon4

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	instlock004 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_d_lockdwon5

Address: Operational Base + offset (0x0928)

reg9_d_lockdwon5

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	datalock005 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_i_lockdwon5

Address: Operational Base + offset (0x092c)

reg9_i_lockdwon5

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	instlock005 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_d_lockdwon6

Address: Operational Base + offset (0x0930)

reg9_d_lockdwon6

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	datalock006 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_i_lockdwon6

Address: Operational Base + offset (0x0934)

reg9_i_lockdwon6

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	instlock006 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_d_lockdwon7

Address: Operational Base + offset (0x0938)

reg9_d_lockdwon7

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	datalock007 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_i_lockdwon7

Address: Operational Base + offset (0x093c)

reg9_i_lockdwon7

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	instlock007 each bit has the following meaning: 0 allocation can occur in the corresponding way. 1 there is no allocation in the corresponding way

L2C_reg9_lock_line_en

Address: Operational Base + offset (0x0950)

reg9_lock_line_en

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	lock_down_by_line_en 0 = Lockdown by line disabled. This is the default. 1 = Lockdown by line enabled.

L2C_reg9_unlock_way

Address: Operational Base + offset (0x0954)

reg9_unlock_way

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	unlock_all_lines_by_way_op For all bits: 0 = Unlock all lines disabled. This is the default. 1 = Unlock all lines operation in progress for the corresponding way.

L2C_reg12_addr_filtering_start

Address: Operational Base + offset (0x0c00)

reg12_addr_filtering_start

Bit	Attr	Reset Value	Description
31:20	RW	0x000	address_filtering_start Address filtering start address for bits [31:20] of the filtering address
19:1	RO	0x0	reserved
0	RW	0x0	filter_en 0 = Address filtering disabled. 1 = Address filtering enabled

L2C_reg12_addr_filtering_end

Address: Operational Base + offset (0x0c04)

reg12_addr_filtering_end

Bit	Attr	Reset Value	Description
31:20	RW	0x000	address_filtering_end Address filtering end address for bits [31:20] of the filtering address.
19:0	RO	0x000	reserved

L2C_reg15_debug_ctrl

Address: Operational Base + offset (0x0f40)

Debug Register o

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2	RW	0x0	SPNIDEN Reads value of SPNIDEN input.
1	RW	0x0	DWB 0 = Enable write-back behavior. This is the default. 1 = Force write-through behavior.
0	RW	0x0	DCL 0 = Enable cache linefills. This is the default. 1 = Disable cache linefills.

L2C_reg15_prefetch_ctrl

Address: Operational Base + offset (0x0f60)

Prefetch Control Register

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved
30	RW	0x0	double_linefill_en You can set the following options for this register bit: 0 The L2CC always issues 4x64-bit read bursts to L3 on reads that miss in the L2 cache. This is the default. 1 The L2CC issues 8x64-bit read bursts to L3 on reads that miss in the L2 cache.
29	RW	0x0	inst_prf_en You can set the following options for this register bit: 0 Instruction prefetching disabled. This is the default. 1 Instruction prefetching enabled.

Bit	Attr	Reset Value	Description
28	RW	0x0	<p>data_prf_en</p> <p>You can set the following options for this register bit:</p> <ul style="list-style-type: none"> 0 Data prefetching disabled. This is the default. 1 Data prefetching enabled.
27	RW	0x0	<p>double_linefill_on_wrap</p> <p>You can set the following options for this register bit:</p> <ul style="list-style-type: none"> 0 Double linefill on WRAP read enabled. This is the default. 1 Double linefill on WRAP read disabled.
26:25	RO	0x0	reserved
24	RW	0x0	<p>prf_drop_en</p> <p>You can set the following options for this register bit:</p> <ul style="list-style-type: none"> 0 The L2CC does not discard prefetch reads issued to L3. This is the default. 1 The L2CC discards prefetch reads issued to L3 when there is a resource conflict with explicit reads
23	RW	0x0	<p>incr_db_lf_en</p> <p>incr_db_lf_en</p> <p>You can set the following options for this register bit:</p> <ul style="list-style-type: none"> 0 The L2CC does not issue INCR 8x64-bit read bursts to L3 on reads that miss in the L2 cache. This is the default. 1 The L2CC can issue INCR 8x64-bit read bursts to L3 on reads that miss in the L2 cache.
22	RO	0x0	reserved
21	RW	0x0	<p>excl_seq_en</p> <p>You can set the following options for this register bit:</p> <ul style="list-style-type: none"> 0 Read and write portions of a non-cacheable exclusive sequence have the same AXI ID when issued to L3. This is the default. 1 Read and write portions of a non-cacheable exclusive sequence do not have the same AXI ID when issued to L3.
20:5	RO	0x0	reserved
4:0	RW	0x00	<p>prf_offset</p> <p>Default = b00000</p>

L2C_reg15_power_ctrl

Address: Operational Base + offset (0x0f80)

Power Control Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x0	dynamic_clk_gating_en 1 = Enabled. 0 = Masked. This is the default
0	RW	0x0	standby_mode_en 1 = Enabled. 0 = Masked. This is the default.

8.5 Application Notes

8.5.1 Address filtering

When address_filtering_enable is set, all accesses with address \geq address_filtering_start and $<$ address_filtering_end are automatically directed to M1. All other accesses are directed to M0.

Because the input pins provide the reset values of the address filtering registers, it is not expected that the values of these registers are changed dynamically after reset. Furthermore, changing these values without special attention can lead to unpredictable behavior.

It is recommended that you program the Address Filtering End Register before the Address Filtering Start Register to avoid unpredictable behavior between the two writes.

8.5.2 L2 Cache initialization

A typical cache controller start-up programming sequence consists of the following register operations:

1. Write to the Auxiliary, Tag RAM Latency, Data RAM Latency, Prefetch, and PowerControl registers using a read-modify-write to set up global configurations:
 - associativity, Way Size
 - latencies for RAM accesses
 - allocation policy
 - prefetch and power capabilities.
 2. Secure write to the Invalidate by Way, offset 0x77C, to invalidate all entries in cache:
 - Write 0xFFFF to 0x77C
 - Poll cache maintenance register until invalidate operation is complete.
 3. Write to the Lockdown D and Lockdown I Register 9 if required.
 4. Write to interrupt clear register to clear any residual raw interrupts set.
 5. Write to the Interrupt Mask Register if you want to enable interrupts.
 6. Write to Control Register 1 with the LSB set to 1 to enable the cache.
- If you write to the Auxiliary, Tag RAM Latency, or Data RAM Latency Control

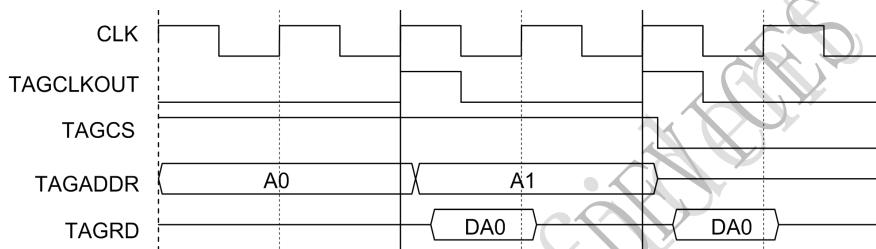
Register with the L2 cache enabled, this results in a SLVERR. You must disable the L2 cache by writing to the Control Register 1 before writing to the Auxiliary, Tag RAM Latency, or Data RAM Latency Control Register.

8.5.3 L2 ram latency programming

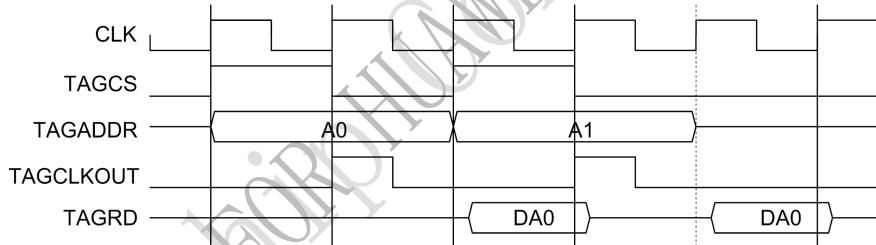
Programmable RAM latencies enable the cache controller to manage RAMs requiring several clock cycles for dealing with accesses. For each RAM, there are three programmable latencies:

- setup
- read access
- write access.

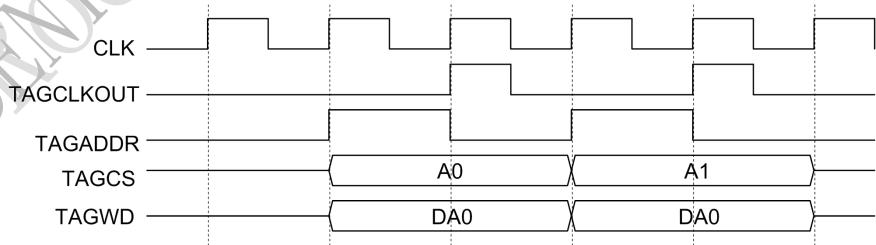
Setup latency is the number of cycles that the RAM control signals remain valid prior to the RAM clock edge. Following figure shows a timing diagram where the tag RAM setup latency has been programmed with the value 0x1.



Read access latency is the number of cycles taken by the read data to become valid after the RAM clock edge. Following figure shows a timing diagram where the tag RAM read latency has been programmed with the value 0x1.



Write access latency is the minimum number of cycles between a RAM clock edge for a write access and the next RAM clock edge corresponding to another access, read or write. Following figure shows a timing diagram where the tag RAM write access latency has been programmed with the value 0x1.



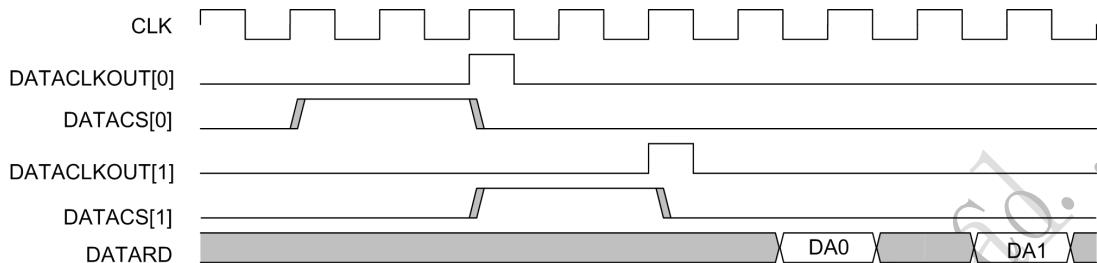
In typical use, the tag ram latency constrained for setup/read/write and correspond register values should be set are like following:

Item	Setup latency	Read latency	Write latency
Cycles	1	1	1
Register filed value	0x0	0x0	0x0

As the tag ram's min period width is 0.8ns, the write latency must be set to 2 cycles if the core is over-frequency to 1.25Ghz.

The data ram setup/read/write latency is like the tag ram. The only difference is data ram use the banking technology. Following figure shows the benefit of the banking when two consecutive reads targeting different banks are treated with the following programmed latencies:

- Data RAM setup latency = 2 cycles, programmed value = 0x1
- Data RAM read latency = 4 cycles, programmed value = 0x3.



In typical use, the data ram latency constrained for setup/read/write and correspond register values should be set are like following:

Item	Setup latency	Read latency	Write latency
Cycles	2	4	1
Register filed value	0x1	0x3	0x0

The data ram read latency is constrained as 4-cycles. Following table shows the data ram read latency's most reasonable value under different core frequency.

Core frequency mhz	0~380	380~560	560~750	>750
Cycles	2	3	4	4
Register filed value	0x0	0x1	0x2	0x3

The data ram setup latency is constrained as 2-cycles. Following table shows the data ram read latency's most reasonable value under different core frequency.

Core frequency mhz	0~560	560~750	>750
Cycles	1	2	2
Register filed value	0x0	0x1	0x1

8.5.4 L2 data ram mutiplexing

The data ram size is 256KB and reside in the pd_cpu power domain. There are 3 ways to use the data ram:

- 256KB used as I2c data ram
- 256KB used as share memory
- 128KB used as I2c data ram, the rest 128KB used as share memory
It's default to use the 256KB ram as I2c data ram.

The register grf_soc_con0[6:5] need to be set to 0x01 , when use 256KB as share memory. And need to be set to 0x10, when use 128KB as share memory.

The register grf_cpu_con0[11:9] need to be set to 0x001 , when use 128KB as share memory.

Chapter 9 AXI interconnect

The chip-level interconnect consists of one cpu_sys interconnect and peri_sys interconnects. It enables communication among the modules and subsystems in the device.

The cpu_sys interconnect handles many types of data transfers, especially exchanges with system-on-chip (SoC)/external memories. It transfers data with a maximum width of 128 bits from the initiator to the target. It is a little-endian platform.

The peri_sys interconnect belongs to the peri system which is responsible for peripheral devices control such as usb device , flash device , uart , spi etc.

For detailed information about **AXI interconnect**, please refer to **RK3168 AXI interconnect.pdf**.

Chapter 10 DMAC0(DMA Controller)

10.1 Overview

This device supports 2 Direct Memory Access (DMA) tops, one for cpu system (DMAC0), and the other one for Peripheral system(DMAC1).Both of these two dma support transfers between memory and memory, peripheral and memory.

DMAC0 supports TrustZone technology and is under secure state after reset.The secure state can be changed by configuring TZPC module.

DMAC0 is mainly used for data transfer of the following slaves: I2S0/I2S1/SPDIF/UART0/Embedded SRAM and transfer data from/to external DDR SDRAM.

Following table shows the DMAC0 peripheral request mapping scheme.

Table 10- 1DMAC0 Request Mapping Table

Req number	Source	Polarity
0	Uart0 tx	High level
1	Uart0 rx	High level
2	Uart1 tx	High level
3	Uart1 rx	High level
4	Reserved	High level
5	Reserved	High level
6	I2S1/PCM(2ch) tx	High level
7	I2S1/PCM(2ch) rx	High level
8	SPDIF tx	High level
9	Reserved	High level
10	Reserved	High level

DMAC0 supports the following features:

- Supports Trustzone technology.
- Supports 10 perihpral request.
- Up to 64bits data size.
- 6 channel at the same time.
- Up to burst 16.
- 1 interrupt output and one abort output.
- Supports 32 MFIFO depth.

10.2 Block Diagram

Figure 10-1 shows the block diagram of DMAC0

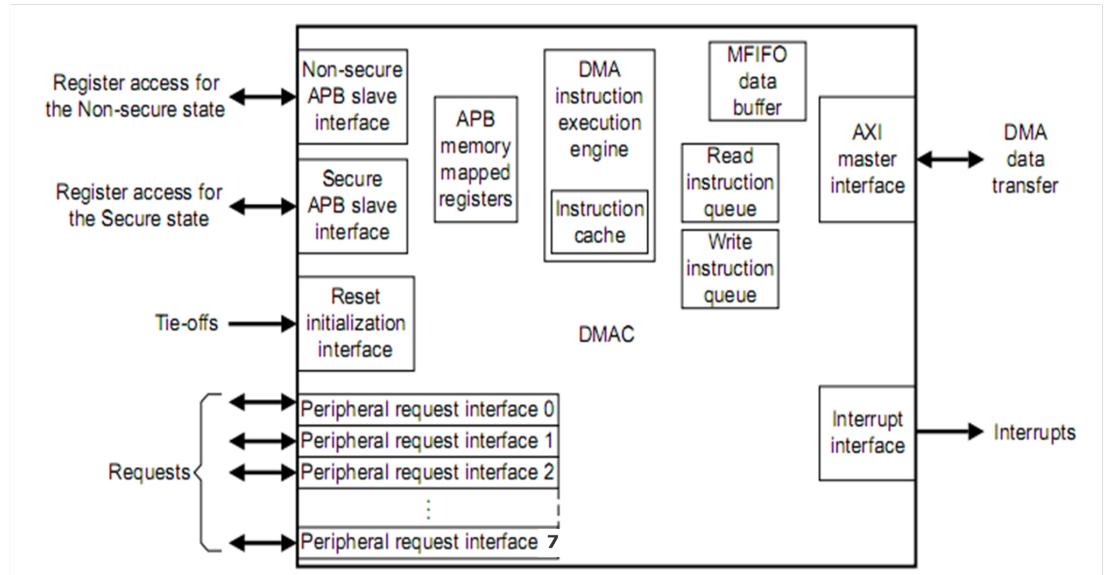


Fig. 10-1 Block diagram of dmac0

As the DMAC0 supports Trustzone technology, so dual APB interfaces enable the operation of the DMAC0 to be partitioned into the Secure state and Non-secure state. You can use the APB interfaces to access status registers and also directly execute instructions in the DMAC0. The default interface after reset is secure apb interface.

10.3 Function Description

10.3.1 Introduction

The DMAC contains an instruction processing block that enables it to process program code that controls a DMA transfer. The program code is stored in a region of system memory that the DMAC accesses using its AXI interface. The DMAC stores instructions temporarily in a cache.

DMAC0 supports 7 channels, each channel capable of supporting a single concurrent thread of DMA operation. In addition, a single DMA manager thread exists, and you can use it to initialize the DMA channel threads. The DMAC executes up to one instruction for each AXI clock cycle. To ensure that it regularly executes each active thread, it alternates by processing the DMA manager thread and then a DMA channel thread. It uses a round-robin process when selecting the next active DMA channel thread to execute.

The DMAC uses variable-length instructions that consist of one to six bytes. It provides a separate Program Counter (PC) register for each DMA channel. When a thread requests an instruction from an address, the cache performs a look-up. If a cache hit occurs, then the cache immediately provides the data. Otherwise, the thread is stalled while the DMAC uses the AXI interface to perform a cache line fill. If an instruction is greater than 4 bytes, or spans the end of a cache line, the DMAC performs multiple cache accesses to fetch the instruction.

When a cache line fill is in progress, the DMAC enables other threads to access the cache, but if another cache miss occurs, this stalls the pipeline until the first line fill is complete.

When a DMA channel thread executes a load or store instruction, the DMAC adds the instruction to the relevant read or write queue. The DMAC uses these queues as an instruction storage buffer prior to it issuing the instructions on the AXI bus. The DMAC also contains a Multi First-In-First-Out (MFIFO) data buffer that it uses to store data that it reads, or writes, during a DMA transfer.

10.3.2 Operating states

Figure shows the operating states for the DMA manager thread and DMA channel threads.

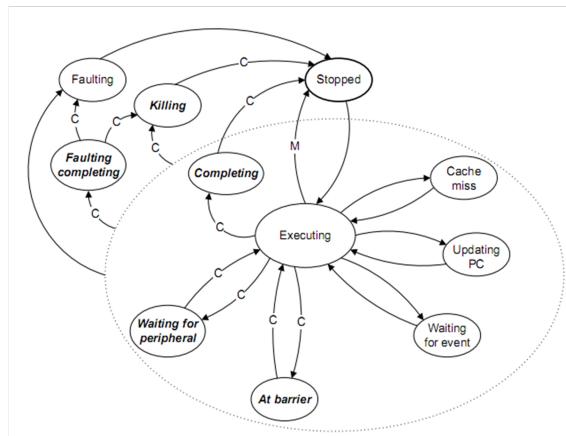


Fig. 10-2 DMAC0 operation states

Note:

arcs with no letter designator indicate state transitions for the DMA manager and DMA channel threads, otherwise use is restricted as follows:

C DMA channel threads only.

M DMA manager thread only.

After the DMAC exits from reset, it sets all DMA channel threads to the stopped state, and the status of boot_from_pc(tie-off interface of dmac) controls the DMA manager thread state:

boot_from_pc is LOW :DMA manager thread moves to the Stopped state.
boot from pc is HIGH :DMA manager thread moves to the Executing state.

10.4 Register Description

10.4.1 Register summary

Name	Offset	Size	Reset Value	Description
DMAC0_DSR	0x0000	W	0x0	DMA Status Register.
DMAC0_DPC	0x0004	W	0x0	DMA Program Counter Register.
-	-	-	-	reserved
DMAC0_INTEN	0x0020	W	0x0	Interrupt Enable Register
DMAC0_EVENT_RIS	0x0024	W	0x0	Event Status Register.
DMAC0_INTMIS	0x0028	W	0x0	Interrupt Status Register
DMAC0_INTCLR	0x002C	W	0x0	Interrupt Clear Register
DMAC0_FSRD	0x0030	W	0x0	Fault Status DMA Manager Register.
DMAC0_FSRC	0x0034	W	0x0	Fault Status DMA Channel

				Register.
DMAC0_FTRD	0x0038	W	0x0	Fault Type DMA Manager Register.
-	-	-	-	reserved
DMAC0_FTR0	0x0040	W	0x0	Fault type for DMA Channel 0
DMAC0_FTR1	0x0044	W	0x0	Fault type for DMA Channel 1
DMAC0_FTR2	0x0048	W	0x0	Fault type for DMA Channel 2
DMAC0_FTR3	0x004C	W	0x0	Fault type for DMA Channel 3
DMAC0_FTR4	0x0050	W	0x0	Fault type for DMA Channel 4
DMAC0_FTR5	0x0054	W	0x0	Fault type for DMA Channel 5
-	-	-	-	reserved
DMAC0_CSR0	0x0100	W	0x0	Channel Status for DMA Channel 0
DMAC0_CSR1	0x0108	W	0x0	Channel Status for DMA Channel 1
DMAC0_CSR2	0x0110	W	0x0	Channel Status for DMA Channel 2
DMAC0_CSR3	0x0118	W	0x0	Channel Status for DMA Channel 3
DMAC0_CSR4	0x0120	W	0x0	Channel Status for DMA Channel 4
DMAC0_CSR5	0x0128	W	0x0	Channel Status for DMA Channel 5
DMAC0_CPC0	0x0104	W	0x0	Channel PC for DMA Channel 0
DMAC0_CPC1	0x010c	W	0x0	Channel PC for DMA Channel 1
DMAC0_CPC2	0x0114	W	0x0	Channel PC for DMA Channel 2
DMAC0_CPC3	0x011c	W	0x0	Channel PC for DMA Channel 3
DMAC0_CPC4	0x0124	W	0x0	Channel PC for DMA Channel 4
DMAC0_CPC5	0x012c	W	0x0	Channel PC for DMA Channel 5
DMAC0_SAR0	0x0400	W	0x0	Source Address for DMA Channel 0
DMAC0_SAR1	0x0420	W	0x0	Source Address for DMA Channel 1
DMAC0_SAR2	0x0440	W	0x0	Source Address for DMA Channel 2
DMAC0_SAR3	0x0460	W	0x0	Source Address for DMA Channel 3
DMAC0_SAR4	0x0480	W	0x0	Source Address for DMA Channel 4
DMAC0_SAR5	0x04a0	W	0x0	Source Address for DMA Channel 5
DMAC0_DAR0	0x0404	W	0x0	Dest Address for DMA Channel 0
DMAC0_DAR1	0x0424	W	0x0	Dest Address for DMA Channel 1
DMAC0_DAR2	0x0444	W	0x0	Dest Address for DMA Channel 2
DMAC0_DAR3	0x0464	W	0x0	Dest Address for DMA Channel 3
DMAC0_DAR4	0x0484	W	0x0	Dest Address for DMA Channel 4
DMAC0_DAR5	0x04a4	W	0x0	Dest Address for DMA Channel 5

DMAC0_CCR0	0x0408	W	0x0	Channel Control for DMA Channel 0
DMAC0_CCR1	0x0428	W	0x0	Channel Control for DMA Channel 1
DMAC0_CCR2	0x0448	W	0x0	Channel Control for DMA Channel 2
DMAC0_CCR3	0x0468	W	0x0	Channel Control for DMA Channel 3
DMAC0_CCR4	0x0488	W	0x0	Channel Control for DMA Channel 4
DMAC0_CCR5	0x04a8	W	0x0	Channel Control for DMA Channel 5
DMAC0_LC0_0	0x040C	W	0x0	Loop Counter 0 for DMA Channel 0
DMAC0_LC0_1	0x042C	W	0x0	Loop Counter 0 for DMA Channel 1
DMAC0_LC0_2	0x044C	W	0x0	Loop Counter 0 for DMA Channel 2
DMAC0_LC0_3	0x046C	W	0x0	Loop Counter 0 for DMA Channel 3
DMAC0_LC0_4	0x048C	W	0x0	Loop Counter 0 for DMA Channel 4
DMAC0_LC0_5	0x04aC	W	0x0	Loop Counter 0 for DMA Channel 5
DMAC0_LC1_0	0x0410	W	0x0	Loop Counter 1 for DMA Channel 0
DMAC0_LC1_1	0x0430	W	0x0	Loop Counter 1 for DMA Channel 1
DMAC0_LC1_2	0x0450	W	0x0	Loop Counter 1 for DMA Channel 2
DMAC0_LC1_3	0x0470	W	0x0	Loop Counter 1 for DMA Channel 3
DMAC0_LC1_4	0x0490	W	0x0	Loop Counter 1 for DMA Channel 4
DMAC0_LC1_5	0x04b0	W	0x0	Loop Counter 1 for DMA Channel 5
-	-	-	-	reserved
DMAC0_DBGST	0x0D00	W	0x0	Debug Status Register.
DMAC0ATUS	0x0D04	W	0x0	Debug Command Register.
DMAC0DBGCMD	0x0D08	W	0x0	Debug Instruction-0 Register.
DMAC0DBGINS T0	0x0D0C	W	0x0	Debug Instruction-1 Register.
DMAC0DBGINS T1	0x0E00	W		Configuration Register 0.
DMAC0CR1	0x0E04	W		Configuration Register 1.
DMAC0CR2	0x0E08	W		Configuration Register 2.
DMAC0CR3	0x0E0C	W		Configuration Register 3.
DMAC0CR4	0x0E10	W		Configuration Register 4.
DMAC0CRDn	0x0E14	W		Configuration Register Dn.
DMAC0WD	0x0E80	W	0x0	Watchdog Register.

Notes:

Size: **B** – Byte (8 bits) access, **HW** – Half WORD (16 bits) access, **W** – WORD (32 bits) access

10.4.2 Detail Register Description

DMAC0_DSR

Address:Operational Base+0x0

DMA Manager Status Register

Bit	Attr	Reset Value	Description
31:10	-	-	Reserved
9	R	0x0	Provides the security status of the DMA manager thread: 0 = DMA manager operates in the Secure state 1 = DMA manager operates in the Non-secure state.
8:4	R	0x0	When the DMA manager thread executes a DMAWFE instruction, it waits for the following event to occur: b00000 = event[0] b00001 = event[1] b00010 = event[2] ... b11111 = event[31].
3:0	R	0x0	The operating state of the DMA manager: b0000 = Stopped b0001 = Executing b0010 = Cache miss b0011 = Updating PC b0100 = Waiting for event b0101-b1110 = reserved b1111 = Faulting.

DMAC0_DPC

Address:Operational Base+0x4

DMA Program Counter Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Program counter for the DMA manager thread

DMAC0_INTEN

Address:Operational Base+0x20

Interrupt Enable Register

Bit	Attr	Reset Value	Description
31:0	RW	0x0	Program the appropriate bit to control how the DMAC responds when it executes DMASEV: Bit [N] = 0 If the DMAC executes DMASEV for the event-interrupt resource N then the DMAC signals event N to all of the threads. Set bit [N] to 0 if your system design does not use irq[N] to signal an interrupt request. Bit [N] = 1 If the DMAC executes DMASEV for the event-interrupt resource N then the DMAC sets irq[N] HIGH. Set bit [N] to 1 if your system designer requires irq[N] to signal an interrupt request.

DMAC0_EVENT_RIS

Address:Operational Base+0x24
Event-Interrupt Raw Status Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Returns the status of the event-interrupt resources: Bit [N] = 0 Event N is inactive or irq[N] is LOW. Bit [N] = 1 Event N is active or irq[N] is HIGH.

DMAC0_INTMIS

Address:Operational Base+0x28
Interrupt Status Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the status of the interrupts that are active in the DMAC: Bit [N] = 0 Interrupt N is inactive and therefore irq[N] is LOW. Bit [N] = 1 Interrupt N is active and therefore irq[N] is HIGH

DMAC0_INTCLR

Address:Operational Base+0x2c
Interrupt Clear Register

Bit	Attr	Reset Value	Description
31:0	W	0x0	Controls the clearing of the irq outputs: Bit [N] = 0 The status of irq[N] does not change. Bit [N] = 1 The DMAC sets irq[N] LOW if the INTEN Register programs the DMAC to signal an interrupt. Otherwise, the status of irq[N] does not change.

DMAC0_FSRD

Address:Operational Base+0x30
Fault Status DMA Manager Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the fault status of the DMA manager. Read as: 0 = the DMA manager thread is not in the Faulting state 1 = the DMA manager thread is in the Faulting state.

DMAC0_FSRC

Address:Operational Base+0x34
Fault Status DMA Channel Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Each bit provides the fault status of the corresponding channel. Read as: Bit [N] = 0 No fault is present on DMA channel N. Bit [N] = 1 DMA channel N is in the Faulting or Faulting completing state.

DMAC0_FTRD

Address:Operational Base+0x38
Fault Type DMA Manager Register

Bit	Attr	Reset Value	Description
31	-	-	reserved
30	R	0x0	If the DMA manager aborts, this bit indicates if the erroneous instruction was read from the system memory or from the debug interface: 0 = instruction that generated an abort was read from system memory 1 = instruction that generated an abort was read from the debug interface.
29:17	-	-	reserved
16	R	0x0	Indicates the AXI response that the DMAC receives on the RRESP bus, after the DMA manager performs an instruction fetch: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response
15:6	-	-	reserved
5	R	0x0	Indicates if the DMA manager was attempting to execute DMAWFE or DMASEV with inappropriate security permissions: 0 = DMA manager has appropriate security to execute DMAWFE or DMASEV 1 = a DMA manager thread in the Non-secure state attempted to execute either: <ul style="list-style-type: none">• DMAWFE to wait for a secure event• DMASEV to create a secure event or secure interrupt
4	R	0x0	Indicates if the DMA manager was attempting to execute DMAGO with inappropriate security permissions: 0 = DMA manager has appropriate security to execute DMAGO 1 = a DMA manager thread in the Non-secure state attempted to execute DMAGO to create a DMA channel operating in the Secure state.
3:2	-	-	reserved
1	R	0x0	Indicates if the DMA manager was attempting to execute an instruction operand that was not valid for the configuration of the DMAC: 0 = valid operand 1 = invalid operand.
0	R	0x0	Indicates if the DMA manager was attempting to execute an undefined instruction: 0 = defined instruction 1 = undefined instruction.

DMAC0_FTR0~DMAC0_FTR5

Address:Operational Base+0x40
Operational Base+0x44
Operational Base+0x48
Operational Base+0x4c

Operational Base+0x50
Operational Base+0x54

Fault Type DMA Channel Register

Bit	Attr	Reset Value	Description
31	R	0x0	Indicates if the DMA channel has locked-up because of resource starvation: 0 = DMA channel has adequate resources 1 = DMA channel has locked-up because of insufficient resources. This fault is an imprecise abort
30	R	0x0	If the DMA channel aborts, this bit indicates if the erroneous instruction was read from the system memory or from the debug interface: 0 = instruction that generated an abort was read from system memory 1 = instruction that generated an abort was read from the debug interface. This fault is an imprecise abort but the bit is only valid when a precise abort occurs.
29:19	-	-	reserved
18	R	0x0	Indicates the AXI response that the DMAC receives on the RRESP bus, after the DMA channel thread performs a data read: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response. This fault is an imprecise abort
17	R	0x0	Indicates the AXI response that the DMAC receives on the BRESP bus, after the DMA channel thread performs a data write: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response. This fault is an imprecise abort.
16	R	0x0	Indicates the AXI response that the DMAC receives on the RRESP bus, after the DMA channel thread performs an instruction fetch: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response. This fault is a precise abort.
15:14	-	-	reserved
13	R	0x0	Indicates if the MFIFO did not contain the data to enable the DMAC to perform the DMAST: 0 = MFIFO contains all the data to enable the DMAST to complete 1 = previous DMA LDs have not put enough data in the MFIFO to enable the DMAST to complete. This fault is a precise abort.
12	R	0x0	Indicates if the MFIFO prevented the DMA channel thread from executing DMA LD or DMA ST. Depending on the instruction: DMA LD 0 = MFIFO contains sufficient space 1 = MFIFO is too small to hold the data that DMA LD requires. DMA ST 0 = MFIFO contains sufficient data 1 = MFIFO is too small to store the data to

			enable DMAST to complete. This fault is an imprecise abort
11:8	-	-	reserved
7	R	0x0	Indicates if a DMA channel thread, in the Non-secure state, attempts to program the CCRn Register to perform a secure read or secure write: 0 = a DMA channel thread in the Non-secure state is not violating the security permissions 1 = a DMA channel thread in the Non-secure state attempted to perform a secure read or secure write. This fault is a precise abort
6	R	0x0	Indicates if a DMA channel thread, in the Non-secure state, attempts to execute DMAWFP, DMALDP, DMASTP, or DMAFLUSHP with inappropriate security permissions: 0 = a DMA channel thread in the Non-secure state is not violating the security permissions 1 = a DMA channel thread in the Non-secure state attempted to execute either: <ul style="list-style-type: none">• DMAWFP to wait for a secure peripheral• DMALDP or DMASTP to notify a secure peripheral• DMAFLUSHP to flush a secure peripheral. This fault is a precise abort.
5	R	0x0	Indicates if the DMA channel thread attempts to execute DMAWFE or DMASEV with inappropriate security permissions: 0 = a DMA channel thread in the Non-secure state is not violating the security permissions 1 = a DMA channel thread in the Non-secure state attempted to execute either: <ul style="list-style-type: none">• DMAWFE to wait for a secure event• DMASEV to create a secure event or secure interrupt. This fault is a precise abort.
4:2	-	-	reserved
1	R	0x0	Indicates if the DMA channel thread was attempting to execute an instruction operand that was not valid for the configuration of the DMAC: 0 = valid operand 1 = invalid operand. This fault is a precise abort.
0	R	0x0	Indicates if the DMA channel thread was attempting to execute an undefined instruction: 0 = defined instruction 1 = undefined instruction. This fault is a precise abort

DMAC0_CSR0~DMAC0_CSR5

Address:Operational Base+0x100
Operational Base+0x108

Operational Base+0x110
 Operational Base+0x118
 Operational Base+0x120
 Operational Base+0x128

Channel Status Registers

Bit	Attr	Reset Value	Description
31:22	-	-	reserved
21	R	0x0	The channel non-secure bit provides the security of the DMA channel: 0 = DMA channel operates in the Secure state 1 = DMA channel operates in the Non-secure state
20:16	-	-	reserved
15	R	0x0	When the DMA channel thread executes DMAWFP this bit indicates if the periph operand was set: 0 = DMAWFP executed with the periph operand not set 1 = DMAWFP executed with the periph operand set
14	R	0x0	When the DMA channel thread executes DMAWFP this bit indicates if the burst or single operand were set: 0 = DMAWFP executed with the single operand set 1 = DMAWFP executed with the burst operand set.
13:9	-	-	reserved
8:4	R	0x0	If the DMA channel is in the Waiting for event state or the Waiting for peripheral state then these bits indicate the event or peripheral number that the channel is waiting for: b00000 = DMA channel is waiting for event, or peripheral, 0 b00001 = DMA channel is waiting for event, or peripheral, 1 b00010 = DMA channel is waiting for event, or peripheral, 2 . . . b11111 = DMA channel is waiting for event, or peripheral, 31
3:0	R	0x0	The channel status encoding is: b0000 = Stopped b0001 = Executing b0010 = Cache miss b0011 = Updating PC b0100 = Waiting for event b0101 = At barrier b0110 = reserved b0111 = Waiting for peripheral b1000 = Killing

			b1001 = Completing b1010-b1101 = reserved b1110 = Faulting completing b1111 = Faulting
--	--	--	---

DMAC0_CPC0~DMAC0_CPC5

Address:Operational Base+0x104
 Operational Base+0x10c
 Operational Base+0x114
 Operational Base+0x11c
 Operational Base+0x124
 Operational Base+0x12c

Channel Program Counter Registers

Bit	Attr	Reset Value	Description
31:0	R	0x0	Program counter for the DMA channel n thread

DMAC0_SAR0~DMAC0_SAR5

Address:Operational Base+0x400
 Operational Base+0x420
 Operational Base+0x440
 Operational Base+0x460
 Operational Base+0x480
 Operational Base+0x4a0

Source Address Registers

Bit	Attr	Reset Value	Description
31:0	R	0x0	Address of the source data for DMA channel n

DMAC0_DAR0~DMAC0_DAR5

Address:Operational Base+0x404
 Operational Base+0x424
 Operational Base+0x444
 Operational Base+0x464
 Operational Base+0x484
 Operational Base+0x4a4

DestinationAddress Registers

Bit	Attr	Reset Value	Description
31:0	R	0x0	Address of the Destinationdata for DMA channel n

DMAC0_CCR0~DMAC0_CCR5

Address:Operational Base+0x408
 Operational Base+0x428
 Operational Base+0x448
 Operational Base+0x468
 Operational Base+0x488
 Operational Base+0x4a8

Channel Control Registers

Bit	Attr	Reset Value	Description
31:28	-	-	reserved
27:25	R	0x0	Programs the state of AWCACHE[3,1:0]a when the DMAC writes the destination data. Bit [27] 0 = AWCACHE[3] is LOW 1 = AWCACHE[3] is HIGH. Bit [26] 0 = AWCACHE[1] is LOW

			1 = AWCACHE[1] is HIGH. Bit [25] 0 = AWCACHE[0] is LOW 1 = AWCACHE[0] is HIGH
24:22	R	0x0	Programs the state of AWPROT[2:0]a when the DMAC writes the destination data. Bit [24] 0 = AWPROT[2] is LOW 1 = AWPROT[2] is HIGH. Bit [23] 0 = AWPROT[1] is LOW 1 = AWPROT[1] is HIGH. Bit [22] 0 = AWPROT[0] is LOW 1 = AWPROT[0] is HIGH
21:18	R	0x0	For each burst, these bits program the number of data transfers that the DMAC performs when it writes the destination data: b0000 = 1 data transfer b0001 = 2 data transfers b0010 = 3 data transfers . . . b1111 = 16 data transfers. The total number of bytes that the DMAC writes out of the MFIFO when it executes a DMAST instruction is the product of dst_burst_len and dst_burst_size
17:15	R	0x0	For each beat within a burst, it programs the number of bytes that the DMAC writes to the destination: b000 = writes 1 byte per beat b001 = writes 2 bytes per beat b010 = writes 4 bytes per beat b011 = writes 8 bytes per beat b100 = writes 16 bytes per beat b101-b111 = reserved. The total number of bytes that the DMAC writes out of the MFIFO when it executes a DMAST instruction is the product of dst_burst_len and dst_burst_size.
14	R	0x0	Programs the burst type that the DMAC performs when it writes the destination data: 0 = Fixed-address burst. The DMAC signals AWBURST[0] LOW. 1 = Incrementing-address burst. The DMAC signals AWBURST[0] HIGH.
13:11	R	0x0	Set the bits to control the state of ARCACHE[2:0]a when the DMAC reads the source data. Bit [13] 0 = ARCACHE[2] is LOW 1 = ARCACHE[2] is HIGH. Bit [12] 0 = ARCACHE[1] is LOW 1 = ARCACHE[1] is HIGH. Bit [11] 0 = ARCACHE[0] is LOW 1 = ARCACHE[0] is HIGH.
10:8	R	0x0	Programs the state of ARPROT[2:0]a when the

			DMAC reads the source data. Bit [10] 0 = ARPROT[2] is LOW 1 = ARPROT[2] is HIGH. Bit [9] 0 = ARPROT[1] is LOW 1 = ARPROT[1] is HIGH. Bit [8] 0 = ARPROT[0] is LOW 1 = ARPROT[0] is HIGH.
7:4	R	0x0	For each burst, these bits program the number of data transfers that the DMAC performs when it reads the source data: b0000 = 1 data transfer b0001 = 2 data transfers b0010 = 3 data transfers . . . b1111 = 16 data transfers. The total number of bytes that the DMAC reads into the MFIFO when it executes a DMA LD instruction is the product of src_burst_len and src_burst_size
3:1	R	0x0	For each beat within a burst, it programs the number of bytes that the DMAC reads from the source: b000 = reads 1 byte per beat b001 = reads 2 bytes per beat b010 = reads 4 bytes per beat b011 = reads 8 bytes per beat b100 = reads 16 bytes per beat b101-b111 = reserved. The total number of bytes that the DMAC reads into the MFIFO when it executes a DMA LD instruction is the product of src_burst_len and src_burst_size
0	R	0x0	Programs the burst type that the DMAC performs when it reads the source data: 0 = Fixed-address burst. The DMAC signals ARBURST[0] LOW. 1 = Incrementing-address burst. The DMAC signals ARBURST[0] HIGH

DMAC0_LC0_0~DMAC0_LC0_5

Address: Operational Base+0x40c
 Operational Base+0x42c
 Operational Base+0x44c
 Operational Base+0x46c
 Operational Base+0x48c
 Operational Base+0x4ac

Loop Counter 0 Registers

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:0	R	0x0	Loop counter 0 iterations

DMAC0_LC1_0~DMAC0_LC1_5

Address: Operational Base+0x410
 Operational Base+0x430
 Operational Base+0x450
 Operational Base+0x470
 Operational Base+0x490
 Operational Base+0x4b0

Loop Counter 1 Registers

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:0	R	0x0	Loop counter 1 iterations

DMAC0_DBGSTATUS

Address: Operational Base+0xd00
 Debug Status Register

Bit	Attr	Reset Value	Description
31:2	-	-	reserved
1:0	R	0x0	The debug encoding is as follows: b00 = execute the instruction that the DBGINST [1:0] Registers contain b01 = reserved b10 = reserved b11 = reserved.

DMAC0_DBGCMD

Address: Operational Base+0xd04
 Debug Command Register

Bit	Attr	Reset Value	Description
31:2	-	-	reserved
1:0	W	0x0	The debug encoding is as follows: b00 = execute the instruction that the DBGINST [1:0] Registers contain b01 = reserved b10 = reserved b11 = reserved

DMAC0_DBGINST0

Address: Operational Base+0xd08
 Debug Instruction-0 Register

Bit	Attr	Reset Value	Description
31:24	W	0x0	Instruction byte 1
23:16	W	0x0	Instruction byte 0
15:11	-	-	reserved
10:8	W	0x0	DMA channel number: b000 = DMA channel 0 b001 = DMA channel 1 b010 = DMA channel 2 ... b111 = DMA channel 7
7:1	-	-	reserved
0	W	0x0	The debug thread encoding is as follows: 0 = DMA manager thread 1 = DMA channel.

DMAC0_DBGINST1

Address:Operational Base+0xd0c
Debug Instruction-1 Register

Bit	Attr	Reset Value	Description
31:24	W	0x0	Instruction byte 5
23:16	W	0x0	Instruction byte 4
15:8	W	0x0	Instruction byte 3
7:0	W	0x0	Instruction byte 2

DMAC0_CRO

Address:Operational Base+0xe00
Configuration Register 0

Bit	Attr	Reset Value	Description
31:22	-	-	reserved
21:17	R	0x2	Number of interrupt outputs that the DMAC provides: b00000 = 1 interrupt output, irq[0] b00001 = 2 interrupt outputs, irq[1:0] b00010 = 3 interrupt outputs, irq[2:0] . . . b11111 = 32 interrupt outputs, irq[31:0].
16:12	R	0x7	Number of peripheral request interfaces that the DMAC provides: b00000 = 1 peripheral request interface b00001 = 2 peripheral request interfaces b00010 = 3 peripheral request interfaces . . b11111 = 32 peripheral request interfaces.
11:7	-	-	reserved
6:4	R	0x5	Number of DMA channels that the DMAC supports: b000 = 1 DMA channel b001 = 2 DMA channels b010 = 3 DMA channels . . b111 = 8 DMA channels.
3	-	-	reserved
2	R	0x0	Indicates the status of the boot_manager_ns signal when the DMAC exited from reset: 0 = boot_manager_ns was LOW 1 = boot_manager_ns was HIGH.
1	R	0x0	Indicates the status of the boot_from_pc signal when the DMAC exited from reset: 0 = boot_from_pc was LOW 1 = boot_from_pc was HIGH
0	R	0x1	Supports peripheral requests: 0 = the DMAC does not provide a peripheral

			request interface 1 = the DMAC provides the number of peripheral request interfaces that the num_periph_req field specifies.
--	--	--	---

DMAC0_CR1

Address:Operational Base+0xe04

Configuration Register 1

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:4	R	0x5	[7:4] num_i-cache_lines Number of i-cache lines: b0000 = 1 i-cache line b0001 = 2 i-cache lines b0010 = 3 i-cache lines ... b1111 = 16 i-cache lines.
3	-	-	reserved
2:0	R	0x7	The length of an i-cache line: b000-b001 = reserved b010 = 4 bytes b011 = 8 bytes b100 = 16 bytes b101 = 32 bytes b110-b111 = reserved

DMAC0_CR2

Address:Operational Base+0xe08

Configuration Register 2

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the value of boot_addr[31:0] when the DMAC exited from reset

DMAC0_CR3

Address:Operational Base+0xe0c

Configuration Register 3

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the security state of an event-interrupt resource: Bit [N] = 0 Assigns event<N> or irq[N] to the Secure state. Bit [N] = 1 Assigns event<N> or irq[N] to the Non-secure state.

DMAC0_CR4

Address:Operational Base+0xe10

Configuration Register 4

Bit	Attr	Reset Value	Description
31:0	R	0x6	Provides the security state of the peripheral request interfaces: Bit [N] = 0 Assigns peripheral request interface N to the Secure state. Bit [N] = 1 Assigns peripheral request interface N to the Non-secure state

DMAC0_CRDn

Address: Operational Base+0xe14
DMA Configuration Register

Bit	Attr	Reset Value	Description
31:30	-	-	reserved
29:20	R	0x20	The number of lines that the data buffer contains: b000000000 = 1 line b000000001 = 2 lines ... b111111111 = 1024 lines
19:16	R	0x9	The depth of the read queue: b0000 = 1 line b0001 = 2 lines . . . b1111 = 16 lines.
15	-	-	reserved
14:12	R	0x4	Read issuing capability that programs the number of outstanding read transactions: b000 = 1 b001 = 2 ... b111 = 8
11:8	R	0x7	The depth of the write queue: b0000 = 1 line b0001 = 2 lines . . . b1111 = 16 lines.
7	-	-	reserved
6:4	R	0x3	Write issuing capability that programs the number of outstanding write transactions: b000 = 1 b001 = 2 . . . b111 = 8
3	-	-	reserved
2:0		0x3	The data bus width of the AXI interface: b000 = reserved b001 = reserved b010 = 32-bit b011 = 64-bit b100 = 128-bit b101-b111 = reserved.

DMAC0_WD

Address: Operational Base+0xe80
DMA Watchdog Register

Bit	Attr	Reset Value	Description
-	-	-	reserved
0	RW	0x0	Controls how the DMAC responds when it detects a lock-up condition:

			0 = the DMAC aborts all of the contributing DMA channels and sets irq_abort HIGH 1 = the DMAC sets irq_abort HIGH.
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10.5 Timing Diagram

Following picture shows the relationship between dma_req and dma_ack.

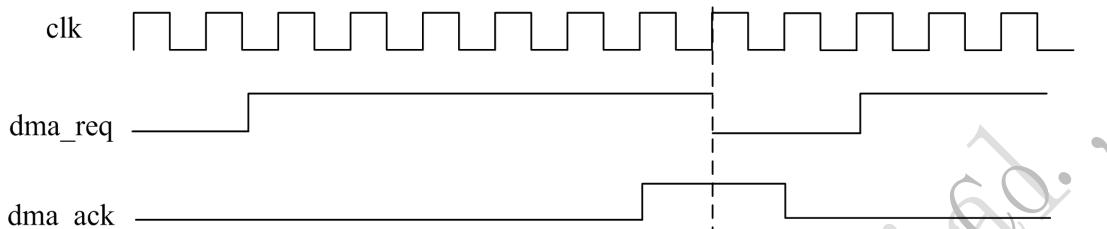


Fig. 10-3 DMAC0 request and acknowledge timing

10.6 Interface Description

DMAC0 has the following tie-off signals. It can be configured by GRF register or TZPC register.(Please refer to these two chapters to find how to configure)

interface	Reset value	Control source
boot_addr	0x0	GRF
boot_from_pc	0x0	GRF
boot_manager_ns	0x1	TZPC
boot_irq_ns	0x6	TZPC
boot_periph_ns	0xff	TZPC

boot_addr

Configures the address location that contains the first instruction the DMAC executes, when it exits from reset.

boot_from_pc

Controls the location in which the DMAC executes its initial instruction, after it exits from reset:

0 = DMAC waits for an instruction from either APB interface

1 = DMA manager thread executes the instruction that is located at the address that

boot_manager_ns

When the DMAC exits from reset, this signal controls the security state of the DMA manager thread:

0 = assigns DMA manager to the Secure state

1 = assigns DMA manager to the Non-secure state.

boot_irq_ns

Controls the security state of an event-interrupt resource, when the DMAC exits from reset:

boot_irq_ns[x] is LOW

The DMAC assigns event<x> or irq[x] to the Secure state.

boot_irq_ns[x] is HIGH

The DMAC assigns event<x> or irq[x] to the Non-secure state.

boot_periph_ns

Controls the security state of a peripheral request interface, when the DMAC exits from reset:

boot_periph_ns[x] is LOW

The DMAC assigns peripheral request interface x to the Secure state.

boot_periph_ns[x] is HIGH

The DMAC assigns peripheral request interface x to the Non-secure state.

10.7 Application Notes

10.7.1 Using the APB slave interfaces

You must ensure that you use the appropriate APB interface, depending on the security state in which the boot_manager_ns initializes the DMAC to operate. For example, if the DMAC is in the Secure state, you must issue the instruction using the secure APB interface, otherwise the DMAC ignores the instruction. You can use the secure APB interface, or the non-secure APB interface, to start or restart a DMA channel when the DMAC is in the Non-secure state.

The necessary steps to start a DMA channel thread using the debug instruction registers as following:

1. Create a program for the DMA channel.
2. Store the program in a region of system memory.
3. Poll the DBGSTATUS Register to ensure that debug is idle, that is, the dbgstatus bit is 0.
4. Write to the DBGINST0 Register and enter the:
 - Instruction byte 0 encoding for DMAGO.
 - Instruction byte 1 encoding for DMAGO.
 - Debug thread bit to 0. This selects the DMA manager thread.
5. Write to the DBGINST1 Register with the DMAGO instruction byte [5:2] data, see Debug Instruction-1 Register o. You must set these four bytes to the address of the first instruction in the program, that was written to system memory in step 2.
6. Writing zero to the DBGCMD Register. The DMAC starts the DMA channel thread and sets the dbgstatus bit to 1.

10.7.2 Security usage

When the DMAC exits from reset, the status of the configuration signals that tie-off signals which described in chapter 10.6.

DMA manager thread is in the Secure state

If the DNS bit is 0, the DMA manager thread operates in the Secure state and it only performs secure instruction fetches. When a DMA manager thread in the Secure state processes:

DMAGO

It uses the status of the ns bit, to set the security state of the DMA

channel thread by writing to the CNS bit for that channel.

DMAWFE

It halts execution of the thread until the event occurs. When the event occurs, the DMAC continues execution of the thread, irrespective of the security state of the corresponding INS bit.

DMASEV

It sets the corresponding bit in the INT_EVENT_RIS Register, irrespective of the security state of the corresponding INS bit.

DMA manager thread is in the Non-secure state

If the DNS bit is 1, the DMA manager thread operates in the Non-secure state, and it only performs non-secure instruction fetches. When a DMA manager thread in the Non-secure state processes:

DMAGO

The DMAC uses the status of the ns bit, to control if it starts a DMA channel thread. If:

ns = 0

The DMAC does not start a DMA channel thread and instead it:

1. Executes a NOP.
2. Sets the FSRD Register, see Fault Status DMA Manager
3. Sets the dmago_err bit in the FTRD Register, see Fault Type DMA Manager Register.
4. Moves the DMA manager to the Faulting state.

ns = 1

The DMAC starts a DMA channel thread in the Non-secure state and programs the CNS bit to be non-secure.

DMAWFE

The DMAC uses the status of the corresponding INS bit, in the CR3 Register, to control if it waits for the event. If:

INS = 0

The event is in the Secure state. The DMAC:

1. Executes a NOP.
2. Sets the FSRD Register, see Fault Status DMA Manager Register.
3. Sets the mgr_evnt_err bit in the FTRD Register, see Fault Type DMA Manager Register.
4. Moves the DMA manager to the Faulting state.

INS = 1

The event is in the Non-secure state. The DMAC halts execution of the thread and waits for the event to occur.

DMASEV

The DMAC uses the status of the corresponding INS bit, in the CR3 Register, to control if it creates the event-interrupt. If:

INS = 0

The event-interrupt resource is in the Secure state. The DMAC:

1. Executes a NOP.
2. Sets the FSRD Register, see Fault Status DMA Manager Register.

3. Sets the mgr_evnt_err bit in the FTRD Register, see Fault Type DMA Manager Register.
4. Moves the DMA manager to the Faulting state.

INS = 1

The event-interrupt resource is in the Non-secure state. The DMAC creates the event-interrupt.

DMA channel thread is in the Secure state

When the CNS bit is 0, the DMA channel thread is programmed to operate in the Secure state and it only performs secure instruction fetches.

When a DMA channel thread in the Secure state processes the following instructions:

DMAWFE

The DMAC halts execution of the thread until the event occurs. When the event occurs, the DMAC continues execution of the thread, irrespective of the security state of the corresponding INS bit, in the CR3 Register.

DMASEV

The DMAC creates the event-interrupt, irrespective of the security state of the corresponding INS bit, in the CR3 Register.

DMAWFP

The DMAC halts execution of the thread until the peripheral signals a DMA request. When this occurs, the DMAC continues execution of the thread, irrespective of the security state of the corresponding PNS bit, in the CR4 Register.

DMALDP, DMASTP

The DMAC sends a message to the peripheral to communicate that data transfer is complete, irrespective of the security state of the corresponding PNS bit, in the CR4 Register.

DMAFLUSHP

The DMAC clears the state of the peripheral and sends a message to the peripheral to resend its level status, irrespective of the security state of the corresponding PNS bit, in the CR4 Register.

When a DMA channel thread is in the Secure state, it enables the DMAC to perform secure and non-secure AXI accesses

DMA channel thread is in the Non-secure state

When the CNS bit is 1, the DMA channel thread is programmed to operate in the Non-secure state and it only performs non-secure instruction fetches.

When a DMA channel thread in the Non-secure state processes the following instructions:

DMAWFE

The DMAC uses the status of the corresponding INS bit, in the CR3 Register, to control if it waits for the event. If:

INS = 0 The event is in the Secure state. The DMAC:

1. Executes a NOP.
2. Sets the appropriate bit in the FSRC Register that corresponds to the DMA channel number. See Fault Status DMA Channel Register.
3. Sets the ch_evnt_err bit in the FTRn Register, see Fault Type DMA Channel Registers.
4. Moves the DMA channel to the Faulting completing state.

INS = 1 The event is in the Non-secure state. The DMAC halts execution of the thread and waits for the event to occur.

DMASEV

The DMAC uses the status of the corresponding INS bit, in the CR3 Register, to control if it creates the event. If:

INS = 0 The event-interrupt resource is in the Secure state. The DMAC:

1. Executes a NOP.
2. Sets the appropriate bit in the FSRC Register that corresponds to the DMA channel number. See Fault Status DMA Channel Register.
3. Sets the ch_evnt_err bit in the FTRn Register, see Fault Type DMA Channel Registers .
4. Moves the DMA channel to the Faulting completing state.

INS = 1 The event-interrupt resource is in the Non-secure state. The DMAC creates the event-interrupt.

DMAWFP

The DMAC uses the status of the corresponding PNS bit, in the CR4 Register, to control if it waits for the peripheral to signal a request. If:

PNS = 0 The peripheral is in the Secure state. The DMAC:

1. Executes a NOP.
2. Sets the appropriate bit in the FSRC Register that corresponds to the DMA channel number. See Fault Status DMA Channel Register.
3. Sets the ch_periph_err bit in the FTRn Register, see Fault Type DMA Channel Registers.
4. Moves the DMA channel to the Faulting completing state.

PNS = 1 The peripheral is in the Non-secure state. The DMAC halts execution of the thread and waits for the peripheral to signal a request.

DMALDP, DMASTP

The DMAC uses the status of the corresponding PNS bit, in the CR4 Register, to control if it sends an acknowledgement to the peripheral. If:

PNS = 0 The peripheral is in the Secure state. The DMAC:

1. Executes a NOP.
2. Sets the appropriate bit in the FSRC Register that corresponds to the DMA channel number. See Fault Status DMA Channel Register.
3. Sets the ch_periph_err bit in the FTRn Register, see Fault Type DMA Channel Registers.
4. Moves the DMA channel to the Faulting completing state.

PNS = 1 The peripheral is in the Non-secure state. The DMAC sends a message to the peripheral to communicate when the data transfer is complete.

DMAFLUSHP

The DMAC uses the status of the corresponding PNS bit, in the CR4 Register, to control if it sends a flush request to the peripheral. If:

PNS = 0 The peripheral is in the Secure state. The DMAC:

1. Executes a NOP.
2. Sets the appropriate bit in the FSRC Register that corresponds to the DMA channel number. See Fault Status DMA Channel Registe.
3. Sets the ch_periph_err bit in the FTRn Register, see Fault Type DMA Channel Registers.
4. Moves the DMA channel to the Faulting completing state.

PNS = 1 The peripheral is in the Non-secure state. The DMAC clears the state of the peripheral and sends a message to the peripheral to resend its level status.

When a DMA channel thread is in the Non-secure state, and a DMAMOV CCR instruction attempts to program the channel to perform a secure AXI transaction, the DMAC:

1. Executes a DMANOP.
2. Sets the appropriate bit in the FSRC Register that corresponds to the DMA channel number. See Fault Status DMA Channel Registe.
3. Sets the ch_rdwr_err bit in the FTRn Register, see Fault Type DMA Channel Registers.
4. Moves the DMA channel thread to the Faulting completing state.

10.7.3 Programming restrictions

Fixed unaligned bursts

The DMAC does not support fixed unaligned bursts. If you program the following conditions, the DMAC treats this as a programming error:

Unaligned read

- src_inc field is 0 in the CCRn Register
- the SARn Register contains an address that is not aligned to the size of data that the src_burst_size field contain

Unaligned write

- dst_inc field is 0 in the CCRn Register
- the DARn Register contains an address that is not aligned to the size of data that the dst_burst_size field contains

Endian swap size restrictions

If you program the endian_swap_size field in the CCRn Register, to enable a DMA channel to perform an endian swap then you must set the corresponding SARn Register and the corresponding DARn Register to contain an address that is aligned to the value that the endian_swap_size field contains.

Updating DMA channel control registers during a DMA cyclerestrictions

Prior to the DMAC executing a sequence of DMALD and DMAST instructions, the values you program in to the CCRn Register, SARn Register, and DARn Register control the data byte lane manipulation that the DMAC performs when it transfers the data from the source address to the destination address. You'd better not update these registers during a DMA cycle.

Resource sharing between DMA channels

DMA channel programs share the MFIFO data storage resource. You must not start a set of concurrently running DMA channel programs with a resource requirement that exceeds the configured size of the MFIFO. If you exceed this limit then the DMAC might lock up and generate a Watchdog abort.

10.7.4 Unaligned transfers may be corrupted

For a configuration with more than one channel, if any of channels 1 to 7 is performing transfers between certain types of misaligned source and destination addresses, then the output data may be corrupted by the action of channel 0.

Data corruption might occur if all of the following are true:

1. Two beats of AXI read data are received for one of channels 1 to 7.
2. Source and destination address alignments mean that each read data beat is split across two lines in the data buffer (see Splitting data, below).
3. There is one idle cycle between the two read data beats .
4. Channel 0 performs an operation that updates channel control information during this idle cycle (see Updates to channel control information, below)

Splitting data

Depending upon the programmed values for the DMA transfer, one beat of read data from the AXI interface may need to be split across two lines in the internal data buffer. This occurs when the read data beat contains datbytes which will be written to addresses that wrap around at the AXI interface data width, so that these bytes could not be transferred by a single AXI write data beat of the full interface width.

Most applications of DMA-330 do not split data in this way, so are NOT vulnerable to data corruption from this defect.

The following cases are NOT vulnerable to data corruption because they do not split data:

- Byte lane offset between source and destination addresses is 0
When source and destination addresses have the same byte lane alignment, the offset is 0 and a wrap operation that splits data cannot occur.
- Byte lane offset between source and destination addresses is a multiple of source size

Source size in CCRn	Allowed offset between SARn and DARn
SS8	any offset allowed.
SS16	0,2,4,6,8,10,12,14
SS32	0,4,8,12
SS64	0,8

10.7.5 Interrupt shares between channel.

As the DMAC0 does not record which channel (or list of channels) have asserted an interrupt. So it will depend on your program and whether any of the visible information for that program can be used to determine progress, and help

identify the interrupt source.

There are 4 likely information sources that can be used to determine the progress made by a program:

- Program counter (PC)
- Source address
- Destination address
- Loop counters (LC)

For example, a program might emit an interrupt each time that it iterates around a loop. In this case, the interrupt service routine (ISR) would need to store the loop value of each channel when it is called, and then compare against the new value when it is next called. A change in value would indicate that the program has progressed.

The ISR must be carefully written to ensure that no interrupts are lost. The sequence of operations is as follows:

1. Disable interrupts
2. Immediately clear the interrupt in DMA-330
3. Check the relevant registers for both channels to determine which must be serviced
4. Take appropriate action for the channels
5. Re-enable interrupts and exit ISR

10.7.6 Instruction sets

Table 10-2 DMAC Instruction sets

Mnemonic	Instruction	Thread usage: • M = DMA manager • C = DMA channel
DMAADDH	Add Halfword	C
DMAEND	End	M/C
DMAFLUSHP	Flush and notify Peripheral	C
DMAGO	Go	M
DMAKILL	Kill	C
DMALD	Load	C
DMALDP	Load Peripheral	C
DMALP	Loop	C
DMALPEND	Loop End	C
DMALPFE	Loop Forever	C
DMAMOV	Move	C
DMANOP	No operation	M/C
DMARMB	Read Memory Barrier	C
DMASEV	Send Event	M/C
DMAST	Store	C
DMASTP	Store and notify Peripheral	C
DMASTZ	Store Zero	C
DMAWFE	Wait For Event M	M/C
DMAWFP	Wait For Peripheral	C
DMAWMB	Write Memory Barrier	C
DMAADNH	Add Negative Halfword	C

10.7.7 Assembler directives

In this document, only DMMADNH instruction is took as an example to show the way the instruction assembled. *For the other instructions , please refer to pl330_trm.pdf.*

DMAADNH

Add Negative Halfword adds an immediate negative 16-bit value to the SARn Register or DARn Register, for the DMA channel thread. This enables the DMA C to support 2D DMA operations, or reading or writing an area of memory in a different order to naturally incrementing addresses. See Source Address Registers and Destination Address Registers.

The immediate unsigned 16-bit value is one-extended to 32 bits, to create a value that is the two's complement representation of a negative number between -65536 and -1, before the DMAC adds it to the address using 32-bit addition. The DMAC discards the carry bit so that addresses wrap from 0xFFFFFFFF to 0x00000000. The net effect is to subtract between 65536 and 1 from the current value in the Source or Destination Address Register.

Following table shows the instruction encoding.

Imm[15:8]	Imm[7:0]	0	1	0	1	1	1	ra	0
-----------	----------	---	---	---	---	---	---	----	---

Assembler syntax

DMAADNH <address_register>, <16-bit immediate>

where:

<address_register>

Selects the address register to use. It must be either:

SAR

SARn Register and sets ra to 0.

DAR

DARn Register and sets ra to 1.

<16-bit immediate>

The immediate value to be added to the <address_register>.

You should specify the 16-bit immediate as the number that is to be represented in the instruction encoding. For example, DMAADNH DAR, 0xFFFF causes the value 0xFFFFFFF0 to be added to the current value of the Destination Address Register, effectively subtracting 16 from the DAR.

You can only use this instruction in a DMA channel thread.

10.7.8 MFIFO usage

For MFIFO usage , please refer to pl330_trm.pdf

Chapter 11 DMAC1(DMA Controller)

11.1 Overview

DMAC1 does not support TrustZone technology and work under non-secure state only.

DMAC1 is mainly used for data transfer of the following slaves: SMC , HSADC, PID_FILTER, SD/MMC, SDIO, eMMC, HIF, UART1, UART2, UART3, SPI0, SPI1.

Following table shows the DMAC1 request mapping scheme.

Table 11- 1DMAC1 Request Mapping Table

Req number	Source	Polarity
0	HSADC/TSI	High level
1	SD/MMC	High level
2	N/A	
3	SDIO	High level
4	eMMC	High level
5	PID_FILTER	High level
6	Uart2 tx	High level
7	Uart2 rx	High level
8	Uart3 tx	High level
9	Uart3 rx	High level
10	Spi0 tx	High level
11	Spi0 rx	High level
12	Spi1 tx	High level
13	Spi1 rx	High level

DMAC1 supports the following features:

- Supports 14 peripheral request.
- Up to 64bits data size.
- 7 channel at the same time.
- Up to burst 16.
- 1 interrupt output and one abort output.
- Supports 64 MFIFO depth.

11.2 Block Diagram

Figure 11-1 shows the block diagram of DMAC1

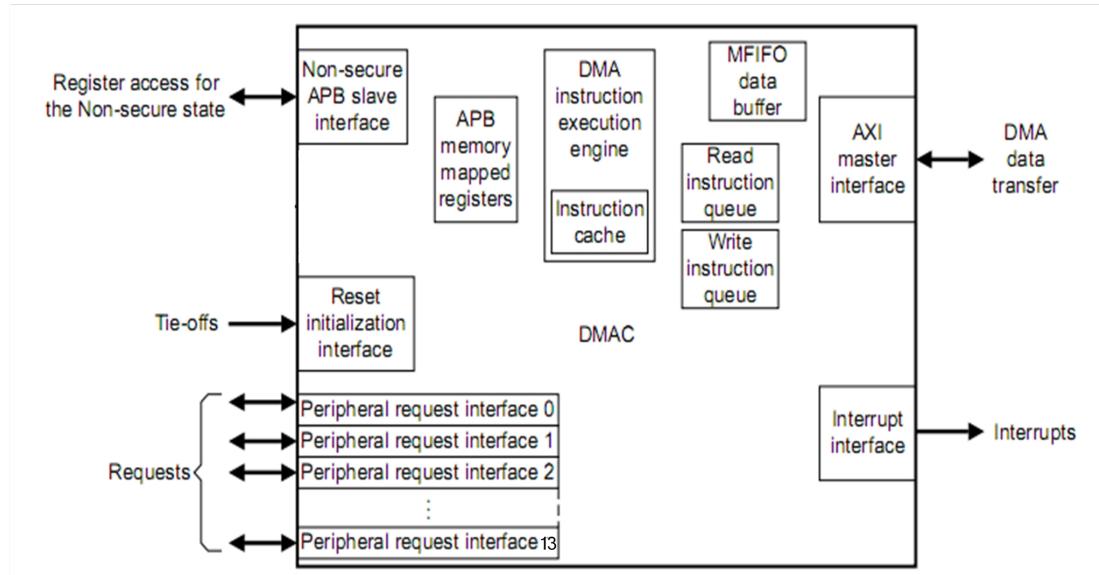


Fig. 11-1 Block diagram of dmac1

11.3 Function Description

Please refer to chapter 10.3 for the similar description.

11.4 Register Description

11.4.1 Register summary

Name	Offset	Size	Reset Value	Description
DMAC1_DSR	0x0000	W	0x0	DMA Status Register.
DMAC1_DPC	0x0004	W	0x0	DMA Program Counter Register.
-	-	-	-	reserved
DMAC1_INTEN	0x0020	W	0x0	Interrupt Enable Register
DMAC1_EVENT_RIS	0x0024	W	0x0	Event Status Register.
DMAC1_INTMIS	0x0028	W	0x0	Interrupt Status Register
DMAC1_INTCLR	0x002C	W	0x0	Interrupt Clear Register
DMAC1_FSRD	0x0030	W	0x0	Fault Status DMA Manager Register.
DMAC1_FSRC	0x0034	W	0x0	Fault Status DMA Channel Register.
DMAC1_FTRD	0x0038	W	0x0	Fault Type DMA Manager Register.
-	-	-	-	reserved
DMAC1_FTR0	0x0040	W	0x0	Fault type for DMA Channel 0
DMAC1_FTR1	0x0044	W	0x0	Fault type for DMA Channel 1
DMAC1_FTR2	0x0048	W	0x0	Fault type for DMA Channel 2
DMAC1_FTR3	0x004C	W	0x0	Fault type for DMA Channel 3
DMAC1_FTR4	0x0050	W	0x0	Fault type for DMA Channel 4
DMAC1_FTR5	0x0054	W	0x0	Fault type for DMA Channel 5
DMAC1_FTR6	0x0058	W	0x0	Fault type for DMA Channel 6
-	-	-	-	reserved
DMAC1_CSR0	0x0100	W	0x0	Channel Status for DMA Channel 0

DMAC1_CSR1	0x0108	W	0x0	Channel Status for DMA Channel 1
DMAC1_CSR2	0x0110	W	0x0	Channel Status for DMA Channel 2
DMAC1_CSR3	0x0118	W	0x0	Channel Status for DMA Channel 3
DMAC1_CSR4	0x0120	W	0x0	Channel Status for DMA Channel 4
DMAC1_CSR5	0x0128	W	0x0	Channel Status for DMA Channel 5
DMAC1_CSR6	0x0130	W	0x0	Channel Status for DMA Channel 6
DMAC1_CPC0	0x0104	W	0x0	Channel PC for DMA Channel 0
DMAC1_CPC1	0x010c	W	0x0	Channel PC for DMA Channel 1
DMAC1_CPC2	0x0114	W	0x0	Channel PC for DMA Channel 2
DMAC1_CPC3	0x011c	W	0x0	Channel PC for DMA Channel 3
DMAC1_CPC4	0x0124	W	0x0	Channel PC for DMA Channel 4
DMAC1_CPC5	0x012c	W	0x0	Channel PC for DMA Channel 5
DMAC1_CPC6	0x0134	W	0x0	Channel PC for DMA Channel 6
DMAC1_SAR0	0x0400	W	0x0	Source Address for DMA Channel 0
DMAC1_SAR1	0x0420	W	0x0	Source Address for DMA Channel 1
DMAC1_SAR2	0x0440	W	0x0	Source Address for DMA Channel 2
DMAC1_SAR3	0x0460	W	0x0	Source Address for DMA Channel 3
DMAC1_SAR4	0x0480	W	0x0	Source Address for DMA Channel 4
DMAC1_SAR5	0x04a0	W	0x0	Source Address for DMA Channel 5
DMAC1_SAR6	0x04c0	W	0x0	Source Address for DMA Channel 6
DMAC1_DAR0	0x0404	W	0x0	Dest Address for DMA Channel 0
DMAC1_DAR1	0x0424	W	0x0	Dest Address for DMA Channel 1
DMAC1_DAR2	0x0444	W	0x0	Dest Address for DMA Channel 2
DMAC1_DAR3	0x0464	W	0x0	Dest Address for DMA Channel 3
DMAC1_DAR4	0x0484	W	0x0	Dest Address for DMA Channel 4
DMAC1_DAR5	0x04a4	W	0x0	Dest Address for DMA Channel 5
DMAC1_DAR6	0x04c4	W	0x0	Dest Address for DMA Channel 6
DMAC1_CCR0	0x0408	W	0x0	Channel Control for DMA Channel 0
DMAC1_CCR1	0x0428	W	0x0	Channel Control for DMA Channel 1
DMAC1_CCR2	0x0448	W	0x0	Channel Control for DMA Channel 2

DMAC1_CCR3	0x0468	W	0x0	Channel Control for DMA Channel 3
DMAC1_CCR4	0x0488	W	0x0	Channel Control for DMA Channel 4
DMAC1_CCR5	0x04a8	W	0x0	Channel Control for DMA Channel 5
DMAC1_CCR6	0x04c8	W	0x0	Channel Control for DMA Channel 6
DMAC1_LC0_0	0x040C	W	0x0	Loop Counter 0 for DMA Channel 0
DMAC1_LC0_1	0x042C	W	0x0	Loop Counter 0 for DMA Channel 1
DMAC1_LC0_2	0x044C	W	0x0	Loop Counter 0 for DMA Channel 2
DMAC1_LC0_3	0x046C	W	0x0	Loop Counter 0 for DMA Channel 3
DMAC1_LC0_4	0x048C	W	0x0	Loop Counter 0 for DMA Channel 4
DMAC1_LC0_5	0x04aC	W	0x0	Loop Counter 0 for DMA Channel 5
DMAC1_LC0_6	0x04cC	W	0x0	Loop Counter 0 for DMA Channel 6
DMAC1_LC1_0	0x0410	W	0x0	Loop Counter 1 for DMA Channel 0
DMAC1_LC1_1	0x0430	W	0x0	Loop Counter 1 for DMA Channel 1
DMAC1_LC1_2	0x0450	W	0x0	Loop Counter 1 for DMA Channel 2
DMAC1_LC1_3	0x0470	W	0x0	Loop Counter 1 for DMA Channel 3
DMAC1_LC1_4	0x0490	W	0x0	Loop Counter 1 for DMA Channel 4
DMAC1_LC1_5	0x04b0	W	0x0	Loop Counter 1 for DMA Channel 5
DMAC1_LC1_6	0x04d0	W	0x0	Loop Counter 1 for DMA Channel 6
-	-	-	-	reserved
DMAC1_DBGST	0x0D00	W	0x0	Debug Status Register.
DMAC1ATUS	0x0D04	W	0x0	Debug Command Register.
DMAC1DBGCMD	0x0D08	W	0x0	Debug Instruction-0 Register.
DMAC1DBGINST0	0x0D0C	W	0x0	Debug Instruction-1 Register.
DMAC1CR0	0x0E00	W		Configuration Register 0.
DMAC1CR1	0x0E04	W		Configuration Register 1.
DMAC1CR2	0x0E08	W		Configuration Register 2.
DMAC1CR3	0x0E0C	W		Configuration Register 3.
DMAC1CR4	0x0E10	W		Configuration Register 4.
DMAC1CRDn	0x0E14	W		Configuration Register Dn.
DMAC1WD	0X0E80	W		Watchdog Register

Notes:

Size: **B** – Byte (8 bits) access, **HW** – Half WORD (16 bits) access, **W** – WORD (32 bits) access

11.4.2 Detail Register Description

DMAC1_DSR

Address:Operational Base+0x0

DMA Manager Status Register

Bit	Attr	Reset Value	Description
31:10	-	-	Reserved
9	R	0x0	Provides the security status of the DMA manager thread: 0 = DMA manager operates in the Secure state 1 = DMA manager operates in the Non-secure state.
8:4	R	0x0	When the DMA manager thread executes a DMAWFE instruction, it waits for the following event to occur: b00000 = event[0] b00001 = event[1] b00010 = event[2] ... b11111 = event[31].
3:0	R	0x0	The operating state of the DMA manager: b0000 = Stopped b0001 = Executing b0010 = Cache miss b0011 = Updating PC b0100 = Waiting for event b0101-b1110 = reserved b1111 = Faulting.

DMAC1_DPC

Address:Operational Base+0x4

DMA Program Counter Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Program counter for the DMA manager thread

DMAC1_INTEN

Address:Operational Base+0x20

Interrupt Enable Register

Bit	Attr	Reset Value	Description
31:0	RW	0x0	Program the appropriate bit to control how the DMAC responds when it executes DMASEV: Bit [N] = 0 If the DMAC executes DMASEV for the event-interrupt resource N then the DMAC signals event N to all of the threads. Set bit [N] to 0 if your system design does not use irq[N] to signal an interrupt request. Bit [N] = 1 If the DMAC executes DMASEV for the event-interrupt resource N then the DMAC sets irq[N] HIGH. Set bit [N] to 1 if your system designer requires irq[N] to signal an interrupt

			request.
--	--	--	----------

DMAC1_EVENT_RIS

Address:Operational Base+0x24

Event-Interrupt Raw Status Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Returns the status of the event-interrupt resources: Bit [N] = 0 Event N is inactive or irq[N] is LOW. Bit [N] = 1 Event N is active or irq[N] is HIGH.

DMAC1_INTMIS

Address:Operational Base+0x28

Interrupt Status Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the status of the interrupts that are active in the DMAC: Bit [N] = 0 Interrupt N is inactive and therefore irq[N] is LOW. Bit [N] = 1 Interrupt N is active and therefore irq[N] is HIGH

DMAC1_INTCLR

Address:Operational Base+0x2c

Interrupt Clear Register

Bit	Attr	Reset Value	Description
31:0	W	0x0	Controls the clearing of the irq outputs: Bit [N] = 0 The status of irq[N] does not change. Bit [N] = 1 The DMAC sets irq[N] LOW if the INTEN Register programs the DMAC to signal an interrupt. Otherwise, the status of irq[N] does not change.

DMAC1_FSRD

Address:Operational Base+0x30

Fault Status DMA Manager Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the fault status of the DMA manager. Read as: 0 = the DMA manager thread is not in the Faulting state 1 = the DMA manager thread is in the Faulting state.

DMAC1_FSRC

Address:Operational Base+0x34

Fault Status DMA Channel Register

Bit	Attr	Reset Value	Description
31:0	R	0x0	Each bit provides the fault status of the corresponding channel. Read as: Bit [N] = 0 No fault is present on DMA channel N.

			Bit [N] = 1 DMA channel N is in the Faulting or Faulting completing state.
--	--	--	--

DMAC1_FTRD

Address:Operational Base+0x38

Fault Type DMA Manager Register

Bit	Attr	Reset Value	Description
31	-	-	reserved
30	R	0x0	If the DMA manager aborts, this bit indicates if the erroneous instruction was read from the system memory or from the debug interface: 0 = instruction that generated an abort was read from system memory 1 = instruction that generated an abort was read from the debug interface.
29:17	-	-	reserved
16	R	0x0	Indicates the AXI response that the DMAC receives on the RRESP bus, after the DMA manager performs an instruction fetch: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response
15:6	-	-	reserved
5	R	0x0	Indicates if the DMA manager was attempting to execute DMAWFE or DMASEV with inappropriate security permissions: 0 = DMA manager has appropriate security to execute DMAWFE or DMASEV 1 = a DMA manager thread in the Non-secure state attempted to execute either: <ul style="list-style-type: none">• DMAWFE to wait for a secure event• DMASEV to create a secure event or secure interrupt
4	R	0x0	Indicates if the DMA manager was attempting to execute DMAGO with inappropriate security permissions: 0 = DMA manager has appropriate security to execute DMAGO 1 = a DMA manager thread in the Non-secure state attempted to execute DMAGO to create a DMA channel operating in the Secure state.
3:2	-	-	reserved
1	R	0x0	Indicates if the DMA manager was attempting to execute an instruction operand that was not valid for the configuration of the DMAC: 0 = valid operand 1 = invalid operand.
0	R	0x0	Indicates if the DMA manager was attempting to execute an undefined instruction: 0 = defined instruction 1 = undefined instruction.

DMAC1_FTR0~DMAC1_FTR6

Address:Operational Base+0x40

Operational Base+0x44
 Operational Base+0x48
 Operational Base+0x4c
 Operational Base+0x50
 Operational Base+0x54
 Operational Base+0x58

Fault Type DMA Channel Register

Bit	Attr	Reset Value	Description
31	R	0x0	Indicates if the DMA channel has locked-up because of resource starvation: 0 = DMA channel has adequate resources 1 = DMA channel has locked-up because of insufficient resources. This fault is an imprecise abort
30	R	0x0	If the DMA channel aborts, this bit indicates if the erroneous instruction was read from the system memory or from the debug interface: 0 = instruction that generated an abort was read from system memory 1 = instruction that generated an abort was read from the debug interface. This fault is an imprecise abort but the bit is only valid when a precise abort occurs.
29:19	-	-	reserved
18	R	0x0	Indicates the AXI response that the DMAC receives on the RRESP bus, after the DMA channel thread performs a data read: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response. This fault is an imprecise abort
17	R	0x0	Indicates the AXI response that the DMAC receives on the BRESP bus, after the DMA channel thread performs a data write: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response. This fault is an imprecise abort.
16	R	0x0	Indicates the AXI response that the DMAC receives on the RRESP bus, after the DMA channel thread performs an instruction fetch: 0 = OKAY response 1 = EXOKAY, SLVERR, or DECERR response. This fault is a precise abort.
15:14	-	-	reserved
13	R	0x0	Indicates if the MFIFO did not contain the data to enable the DMAC to perform the DMAST: 0 = MFIFO contains all the data to enable the DMAST to complete 1 = previous DMALDs have not put enough data in the MFIFO to enable the DMAST to complete. This fault is a precise abort.
12	R	0x0	Indicates if the MFIFO prevented the DMA channel thread from executing DMALD or DMAST. Depending on the instruction: DMALD 0 = MFIFO contains sufficient space

			1 = MFIFO is too small to hold the data that DMA LD requires. DMA ST 0 = MFIFO contains sufficient data 1 = MFIFO is too small to store the data to enable DMA ST to complete. This fault is an imprecise abort
11:8	-	-	reserved
7	R	0x0	Indicates if a DMA channel thread, in the Non-secure state, attempts to program the CCRn Register to perform a secure read or secure write: 0 = a DMA channel thread in the Non-secure state is not violating the security permissions 1 = a DMA channel thread in the Non-secure state attempted to perform a secure read or secure write. This fault is a precise abort
6	R	0x0	Indicates if a DMA channel thread, in the Non-secure state, attempts to execute DMA WFP, DMA LDP, DMA STP, or DMA FLUSH P with inappropriate security permissions: 0 = a DMA channel thread in the Non-secure state is not violating the security permissions 1 = a DMA channel thread in the Non-secure state attempted to execute either: <ul style="list-style-type: none">• DMA WFP to wait for a secure peripheral• DMA LDP or DMA STP to notify a secure peripheral• DMA FLUSH P to flush a secure peripheral. This fault is a precise abort.
5	R	0x0	Indicates if the DMA channel thread attempts to execute DMA WFE or DMA SEV with inappropriate security permissions: 0 = a DMA channel thread in the Non-secure state is not violating the security permissions 1 = a DMA channel thread in the Non-secure state attempted to execute either: <ul style="list-style-type: none">• DMA WFE to wait for a secure event• DMA SEV to create a secure event or secure interrupt. This fault is a precise abort.
4:2	-	-	reserved
1	R	0x0	Indicates if the DMA channel thread was attempting to execute an instruction operand that was not valid for the configuration of the DMAC: 0 = valid operand 1 = invalid operand. This fault is a precise abort.
0	R	0x0	Indicates if the DMA channel thread was attempting to execute an undefined instruction: 0 = defined instruction 1 = undefined instruction. This fault is a precise abort

DMAC1_CSR0~DMAC1_CSR6

Address:Operational Base+0x100

Operational Base+0x108
Operational Base+0x110
Operational Base+0x118
Operational Base+0x120
Operational Base+0x128
Operational Base+0x130

Channel Status Registers

Bit	Attr	Reset Value	Description
31:22	-	-	reserved
21	R	0x0	The channel non-secure bit provides the security of the DMA channel: 0 = DMA channel operates in the Secure state 1 = DMA channel operates in the Non-secure state
20:16	-	-	reserved
15	R	0x0	When the DMA channel thread executes DMAWFP this bit indicates if the periph operand was set: 0 = DMAWFP executed with the periph operand not set 1 = DMAWFP executed with the periph operand set
14	R	0x0	When the DMA channel thread executes DMAWFP this bit indicates if the burst or single operand were set: 0 = DMAWFP executed with the single operand set 1 = DMAWFP executed with the burst operand set.
13:9	-	-	reserved
8:4	R	0x0	If the DMA channel is in the Waiting for event state or the Waiting for peripheral state then these bits indicate the event or peripheral number that the channel is waiting for: b00000 = DMA channel is waiting for event, or peripheral, 0 b00001 = DMA channel is waiting for event, or peripheral, 1 b00010 = DMA channel is waiting for event, or peripheral, 2 . . . b11111 = DMA channel is waiting for event, or peripheral, 31
3:0	R	0x0	The channel status encoding is: b0000 = Stopped b0001 = Executing b0010 = Cache miss b0011 = Updating PC b0100 = Waiting for event

		b0101 = At barrier b0110 = reserved b0111 = Waiting for peripheral b1000 = Killing b1001 = Completing b1010-b1101 = reserved b1110 = Faulting completing b1111 = Faulting
--	--	--

DMAC1_CPC0~DMAC1_CPC6

Address: Operational Base+0x104

Operational Base+0x10c
Operational Base+0x114
Operational Base+0x11c
Operational Base+0x124
Operational Base+0x12c
Operational Base+0x134

Channel Program Counter Registers

Bit	Attr	Reset Value	Description
31:0	R	0x0	Program counter for the DMA channel n thread

DMAC1_SAR0~DMAC1_SAR6

Address: Operational Base+0x400

Operational Base+0x420
Operational Base+0x440
Operational Base+0x460
Operational Base+0x480
Operational Base+0x4a0
Operational Base+0x4c0

Source Address Registers

Bit	Attr	Reset Value	Description
31:0	R	0x0	Address of the source data for DMA channel n

DMAC1_DAR0~DMAC1_DAR5

Address: Operational Base+0x404

Operational Base+0x424
Operational Base+0x444
Operational Base+0x464
Operational Base+0x484
Operational Base+0x4a4

DestinationAddress Registers

Bit	Attr	Reset Value	Description
31:0	R	0x0	Address of the Destinationdata for DMA channel n

DMAC1_CCR0~DMAC1_CCR6

Address: Operational Base+0x408

Operational Base+0x428
Operational Base+0x448
Operational Base+0x468
Operational Base+0x488
Operational Base+0x4a8
Operational Base+0x4c8

Channel Control Registers

Bit	Attr	Reset Value	Description
31:28	-	-	reserved
27:25	R	0x0	Programs the state of AWCACHE[3,1:0]a when the DMAC writes the destination data. Bit [27] 0 = AWCACHE[3] is LOW 1 = AWCACHE[3] is HIGH. Bit [26] 0 = AWCACHE[1] is LOW 1 = AWCACHE[1] is HIGH. Bit [25] 0 = AWCACHE[0] is LOW 1 = AWCACHE[0] is HIGH
24:22	R	0x0	Programs the state of AWPROT[2:0]a when the DMAC writes the destination data. Bit [24] 0 = AWPROT[2] is LOW 1 = AWPROT[2] is HIGH. Bit [23] 0 = AWPROT[1] is LOW 1 = AWPROT[1] is HIGH. Bit [22] 0 = AWPROT[0] is LOW 1 = AWPROT[0] is HIGH
21:18	R	0x0	For each burst, these bits program the number of data transfers that the DMAC performs when it writes the destination data: b0000 = 1 data transfer b0001 = 2 data transfers b0010 = 3 data transfers . . . b1111 = 16 data transfers. The total number of bytes that the DMAC writes out of the MFIFO when it executes a DMAST instruction is the product of dst_burst_len and dst_burst_size
17:15	R	0x0	For each beat within a burst, it programs the number of bytes that the DMAC writes to the destination: b000 = writes 1 byte per beat b001 = writes 2 bytes per beat b010 = writes 4 bytes per beat b011 = writes 8 bytes per beat b100 = writes 16 bytes per beat b101-b111 = reserved. The total number of bytes that the DMAC writes out of the MFIFO when it executes a DMAST instruction is the product of dst_burst_len and dst_burst_size.
14	R	0x0	Programs the burst type that the DMAC performs when it writes the destination data: 0 = Fixed-address burst. The DMAC signals AWBURST[0] LOW. 1 = Incrementing-address burst. The DMAC signals AWBURST[0] HIGH.
13:11	R	0x0	Set the bits to control the state of ARCACHE[2:0]a when the DMAC reads the source data.

			Bit [13] 0 = ARCACHE[2] is LOW 1 = ARCACHE[2] is HIGH. Bit [12] 0 = ARCACHE[1] is LOW 1 = ARCACHE[1] is HIGH. Bit [11] 0 = ARCACHE[0] is LOW 1 = ARCACHE[0] is HIGH.
10:8	R	0x0	Programs the state of ARPROT[2:0]a when the DMAC reads the source data. Bit [10] 0 = ARPROT[2] is LOW 1 = ARPROT[2] is HIGH. Bit [9] 0 = ARPROT[1] is LOW 1 = ARPROT[1] is HIGH. Bit [8] 0 = ARPROT[0] is LOW 1 = ARPROT[0] is HIGH.
7:4	R	0x0	For each burst, these bits program the number of data transfers that the DMAC performs when it reads the source data: b0000 = 1 data transfer b0001 = 2 data transfers b0010 = 3 data transfers . . . b1111 = 16 data transfers. The total number of bytes that the DMAC reads into the MFIFO when it executes a DMA LD instruction is the product of src_burst_len and src_burst_size
3:1	R	0x0	For each beat within a burst, it programs the number of bytes that the DMAC reads from the source: b000 = reads 1 byte per beat b001 = reads 2 bytes per beat b010 = reads 4 bytes per beat b011 = reads 8 bytes per beat b100 = reads 16 bytes per beat b101-b111 = reserved. The total number of bytes that the DMAC reads into the MFIFO when it executes a DMA LD instruction is the product of src_burst_len and src_burst_size
0	R	0x0	Programs the burst type that the DMAC performs when it reads the source data: 0 = Fixed-address burst. The DMAC signals ARBURST[0] LOW. 1 = Incrementing-address burst. The DMAC signals ARBURST[0] HIGH

DMAC1_LC0_0~DMAC1_LC0_6

Address: Operational Base+0x40c

Operational Base+0x42c

Operational Base+0x44c

Operational Base+0x46c

Operational Base+0x48c

Operational Base+0x4ac
Operational Base+0x4cc

Loop Counter 0 Registers

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:0	R	0x0	Loop counter 0 iterations

DMAC1_LC1_0~DMAC1_LC1_6

Address:Operational Base+0x410
Operational Base+0x430
Operational Base+0x450
Operational Base+0x470
Operational Base+0x490
Operational Base+0x4b0
Operational Base+0x4e0

Loop Counter 1 Registers

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:0	R	0x0	Loop counter 1 iterations

DMAC1_DBGSTATUS

Address:Operational Base+0xd00
Debug Status Register

Bit	Attr	Reset Value	Description
31:2	-	-	reserved
1:0	R	0x0	The debug encoding is as follows: b00 = execute the instruction that the DBGINST [1:0] Registers contain b01 = reserved b10 = reserved b11 = reserved.

DMAC1_DBGCMD

Address:Operational Base+0xd04
Debug Command Register

Bit	Attr	Reset Value	Description
31:2	-	-	reserved
1:0	W	0x0	The debug encoding is as follows: b00 = execute the instruction that the DBGINST [1:0] Registers contain b01 = reserved b10 = reserved b11 = reserved

DMAC1_DBGINST0

Address:Operational Base+0xd08
Debug Instruction-0 Register

Bit	Attr	Reset Value	Description
31:24	W	0x0	Instruction byte 1
23:16	W	0x0	Instruction byte 0
17:11	-	-	reserved

10:8	W	0x0	DMA channel number: b000 = DMA channel 0 b001 = DMA channel 1 b010 = DMA channel 2 ... b111 = DMA channel 7
7:1	-	-	reserved
0	W	0x0	The debug thread encoding is as follows: 0 = DMA manager thread 1 = DMA channel.

DMAC1_DBGINST1

Address: Operational Base+0xd0c

Debug Instruction-1 Register

Bit	Attr	Reset Value	Description
31:24	W	0x0	Instruction byte 5
23:16	W	0x0	Instruction byte 4
15:8	W	0x0	Instruction byte 3
7:0	W	0x0	Instruction byte 2

DMAC1_CRO

Address: Operational Base+0xe00

Configuration Register 0

Bit	Attr	Reset Value	Description
31:22	-	-	reserved
21:17	R	0x2	Number of interrupt outputs that the DMAC provides: b00000 = 1 interrupt output, irq[0] b00001 = 2 interrupt outputs, irq[1:0] b00010 = 3 interrupt outputs, irq[2:0] . . . b11111 = 32 interrupt outputs, irq[31:0].
16:12	R	0x7	Number of peripheral request interfaces that the DMAC provides: b00000 = 1 peripheral request interface b00001 = 2 peripheral request interfaces b00010 = 3 peripheral request interfaces . . . b11111 = 32 peripheral request interfaces.
11:7	-	-	reserved
6:4	R	0x5	Number of DMA channels that the DMAC supports: b000 = 1 DMA channel b001 = 2 DMA channels b010 = 3 DMA channels . . . b111 = 8 DMA channels.

3	-	-	reserved
2	R	0x0	Indicates the status of the boot_manager_ns signal when the DMAC exited from reset: 0 = boot_manager_ns was LOW 1 = boot_manager_ns was HIGH.
1	R	0x0	Indicates the status of the boot_from_pc signal when the DMAC exited from reset: 0 = boot_from_pc was LOW 1 = boot_from_pc was HIGH
0	R	0x1	Supports peripheral requests: 0 = the DMAC does not provide a peripheral request interface 1 = the DMAC provides the number of peripheral request interfaces that the num_periph_req field specifies.

DMAC1_CR1

Address:Operational Base+0xe04

Configuration Register 1

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:4	R	0x5	[7:4] num_i-cache_lines Number of i-cache lines: b0000 = 1 i-cache line b0001 = 2 i-cache lines b0010 = 3 i-cache lines ... b1111 = 16 i-cache lines.
3	-	-	reserved
2:0	R	0x7	The length of an i-cache line: b000-b001 = reserved b010 = 4 bytes b011 = 8 bytes b100 = 16 bytes b101 = 32 bytes b110-b111 = reserved

DMAC1_CR2

Address:Operational Base+0xe08

Configuration Register 2

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the value of boot_addr[31:0] when the DMAC exited from reset

DMAC1_CR3

Address:Operational Base+0xe0c

Configuration Register 3

Bit	Attr	Reset Value	Description
31:0	R	0x0	Provides the security state of an event-interrupt resource: Bit [N] = 0 Assigns event<N> or irq[N] to the Secure state. Bit [N] = 1 Assigns event<N> or irq[N] to the Non-secure state.

DMAC1_CR4

Address: Operational Base+0xe10
Configuration Register 4

Bit	Attr	Reset Value	Description
31:0	R	0x6	<p>Provides the security state of the peripheral request interfaces: Bit [N] = 0 Assigns peripheral request interface N to the Secure state. Bit [N] = 1 Assigns peripheral request interface N to the Non-secure state</p>

DMAC1_CRDn

Address: Operational Base+0xe14
DMA Configuration Register

Bit	Attr	Reset Value	Description
31:30	-	-	reserved
29:20	R	0x20	<p>The number of lines that the data buffer contains: b0000000000 = 1 line b0000000001 = 2 lines ... b1111111111 = 1024 lines</p>
19:16	R	0x9	<p>The depth of the read queue: b0000 = 1 line b0001 = 2 lines . . b1111 = 16 lines.</p>
15	-	-	reserved
14:12	R	0x4	<p>Read issuing capability that programs the number of outstanding read transactions: b000 = 1 b001 = 2 ... b111 = 8</p>
11:8	R	0x7	<p>The depth of the write queue: b0000 = 1 line b0001 = 2 lines ... b1111 = 16 lines.</p>
7	-	-	reserved
6:4	R	0x3	<p>Write issuing capability that programs the number of outstanding write transactions: b000 = 1 b001 = 2 ... b111 = 8</p>
3	-	-	reserved
2:0		0x3	<p>The data bus width of the AXI interface: b000 = reserved b001 = reserved b010 = 32-bit</p>

			b011 = 64-bit b100 = 128-bit b101-b111 = reserved.
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DMAC1_WD

Address:Operational Base+0xe80

DMA Watchdog Register

Bit	Attr	Reset Value	Description
31:1	-	-	reserved
0	RW	0x0	Controls how the DMAC responds when it detects a lock-up condition: 0 = the DMAC aborts all of the contributing DMA channels and sets irq_abort HIGH 1 = the DMAC sets irq_abort HIGH.

11.5 Timing Diagram

Please refer to chapter 10.5 for the similar description.

11.6 Interface Description

DMAC1 has the following tie-off signals. It can be configured by GRF register.(Please refer to the chapter to find how to configure)

DMAC1

interface	Reset value	Control source
boot_addr	0x0	GRF
boot_from_pc	0x0	GRF
boot_manager_ns	0x0	GRF
boot_irq_ns	0xf	GRF
boot_periph_ns	0xfffff	GRF

boot_addr

Configures the address location that contains the first instruction the DMAC executes, when it exits from reset.

boot_from_pc

Controls the location in which the DMAC executes its initial instruction, after it exits from reset:

0 = DMAC waits for an instruction from either APB interface

1 = DMA manager thread executes the instruction that is located at the address that

boot_manager_ns

When the DMAC exits from reset, this signal controls the security state of the DMA manager thread:

0 = assigns DMA manager to the Secure state

1 = assigns DMA manager to the Non-secure state.

boot_irq_ns

Controls the security state of an event-interrupt resource, when the DMAC exits from reset:

boot_irq_ns[x] is LOW

The DMAC assigns event<x> or irq[x] to the Secure state.

boot_irq_ns[x] is HIGH

The DMAC assigns event<x> or irq[x] to the Non-secure state.

boot_periph_ns

Controls the security state of a peripheral request interface, when the DMAC exits from reset:

boot_periph_ns[x] is LOW

The DMAC assigns peripheral request interface x to the Secure state.

boot_periph_ns[x] is HIGH

The DMAC assigns peripheral request interface x to the Non-secure state.

11.7 Application Notes

Please refer to chapter 10.3 for the similar description.

Chapter 12 GIC(General Interrupt Controller)

12.1 Overview

The interrupt controller(GIC) in This device has two interfaces, the distributor interface connects to the interrupt source, the cpu interface connects to Cortex-A8. The GIC supports Security Extensions.

It supports the following features:

- Supports 72 vectored IRQ interrupts
- Supports 64 interrupts priority levels
- Programmable interrupt priority level masking
- Generates IRQ and FIQ
- Generates Software interrupt
- Supports Security Extensions

12.2 Block Diagram

Fig.12-1 shows the block diagram of gic

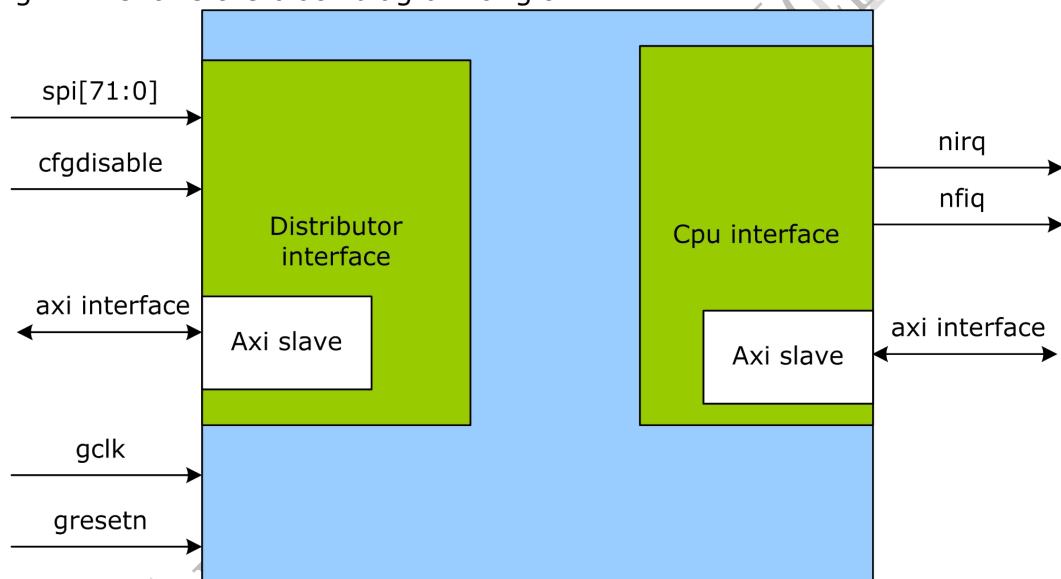


Fig. 12- 1Block diagram of GIC

The diagram shows that GIC has two axi interfaces independently and has two base address for these two interfaces.

These two interfaces connect to CPU L1 AXI interconnect, and the connected ports are secure after reset. So, after reset GIC can only be accessed by secure transaction. These two ports in CPU L1 AXI interconnect can be configured to non-secure , Please refer to chapter 9.3 for detailed information.

12.3 Function Description

This GIC architecture splits logically into a Distributor block and one CPU interface block, as Figure 12-1 shows.

Distributor

This performs interrupt prioritization and distribution to the CPU interface that connect to the processor in the system.

CPU interface

CPU interface performs priority masking and preemption handling for a connected processor in the system.

12.3.1 The Distributor

The Distributor centralizes all interrupt sources, determines the priority of each interrupt, and for CPU interface dispatches the interrupt with the highest priority to the interface for priority masking and preemption handling.

The Distributor provides a programming interface for:

- Globally enabling the forwarding of interrupts to the CPU interface
- Enabling or disabling each interrupt
- Setting the priority level of each interrupt
- Setting the target processor list of each interrupt
- Setting each peripheral interrupt to be level-sensitive or edge-triggered
- If the GIC implements the Security Extensions, setting each interrupt as either
- Secure or Non-secure
- Sending an SGI to processor.
- Visibility of the state of each interrupt
- A mechanism for software to set or clear the pending state of a peripheral interrupt.

Interrupt ID

Interrupts from sources are identified using ID numbers. CPU interface can see up to 88 interrupts.

The GIC assigns interrupt these 88 ID numbers as follows:

- Interrupt numbers ID32-ID1 are used for SPIs(shared peripheral interrupts).
- ID0-ID15 are used for SGIs(software generated interrupts).
- ID16-ID31 are not used

The GIC architecture reserves interrupt ID numbers 1022-1023 for special purposes.

ID1022

The GIC returns this value to a processor in response to an interrupt acknowledge only when all of the following apply:

- The interrupt acknowledge is a Secure read
- The highest priority pending interrupt is Non-secure
- The AckCtl bit in the Secure ICCICR is set to 0
- The priority of the interrupt is sufficient for it to be signalled to the processor.

Interrupt ID 1022 informs Secure software that there is a Non-secure interrupt of sufficient priority to be signalled to the processor, that must be handled by Non-secure software. In this situation the Secure software might alter its schedule to permit Non-secure software to handle the interrupt, to minimize the interrupt latency.

ID1023

This value is returned to a processor, in response to an interrupt acknowledge, if there is no pending interrupt with sufficient priority for it to be signalled to the processor.

On a processor that implements the Security Extensions, Secure software

treats values of 1022 and 1023 as spurious interrupts.

12.3.2 CPU interface

CPU interface block provides the interface for a processor that operates with the GIC. CPU interface provides a programming interface for:

- Enabling the signalling of interrupt requests by the CPU interface
- Acknowledging an interrupt
- Indicating completion of the processing of an interrupt
- Setting an interrupt priority mask for the processor
- Defining the preemption policy for the processor
- Determining the highest priority pending interrupt for the processor.

When enabled, CPU interface takes the highest priority pending interrupt for its connected processor and determines whether the interrupt has sufficient priority for it to signal the interrupt request to the processor.

To determine whether to signal the interrupt request to the processor the CPU interface considers the interrupt priority mask and the preemption settings for the processor. At any time, the connected processor can read the priority of its highest priority active interrupt from a CPU interface register.

The processor acknowledges the interrupt request by reading the CPU interface Interrupt Acknowledge register. The CPU interface returns one of:

The ID number of the highest priority pending interrupt, if that interrupt is of sufficient priority to generate an interrupt exception on the processor. This is the normal response to an interrupt acknowledge.

Exceptionally, an ID number that indicates a spurious interrupt.

When the processor acknowledges the interrupt at the CPU interface, the Distributor changes the status of the interrupt from pending to either active, or active and pending. At this point the CPU interface can signal another interrupt to the processor, to preempt interrupts that are active on the processor. If there is no pending interrupt with sufficient priority for signalling to the processor, the interface deasserts the interrupt request signal to the processor.

When the interrupt handler on the processor has completed the processing of an interrupt, it writes to the CPU interface to indicate interrupt completion.

When this happens, the distributor changes the status of the interrupt either:

- from active to inactive
- from active and pending to pending.

12.3.3 Interrupt handling state machine

The distributor maintains a state machine for each supported interrupt on CPU interface. Following figure shows an instance of this state machine, and the possible state transitions.

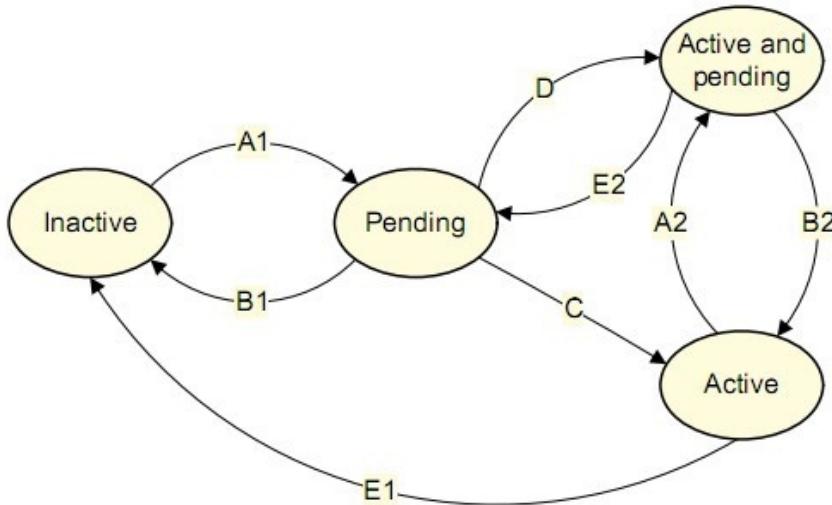


Fig. 12-2 GIC Interrupt handling state machine

Transition A1 or A2, add pending status

For an SGI:

- Occurs on a write to an ICDSGIR that specifies the processor as a target.
- If the GIC implements the Security Extensions and the write to the ICDSGIR is Secure, the transition occurs only if the security configuration of the specified SGI, for the CPU interface, corresponds to the ICDSGIR.SATT bit value.

For an SPI, occurs if either:

- a peripheral asserts an interrupt signal
- software writes to an ICDISPR.

Transition B1 or B2, remove pending status

Not applicable to SGIs:

- a pending SGI must transition through the active state, or reset, to remove its pending status.
- an active and pending SGI must transition through the pending state, or reset, to remove its pending status.

For an SPI, occurs if either:

- the level-sensitive interrupt is pending only because of the assertion of an input signal, and that signal is deasserted
- the interrupt is pending only because of the assertion of an edge-triggered interrupt signal, or a write to an ICDISPR, and software writes to the corresponding ICDICPR.

Transition C

If the interrupt is enabled and of sufficient priority to be signalled to the processor, occurs when software reads from the ICCIAR.

Transition D

For an SGI, occurs if the associated SGI is enabled and the Distributor forwards it to the CPU interface at the same time that the processor reads the ICCIAR to acknowledge a previous instance of the SGI. Whether this transition occurs depends on the timing of the read of the ICCIAR relative to the reforwarding of the SGI.

For an SPI:

- Occurs if all the following apply:
 - The interrupt is enabled.
 - Software reads from the ICCIAR. This read adds the active state to the interrupt.
 - For a level-sensitive interrupt, the interrupt signal remains asserted. This is usually the case, because the peripheral does not deassert the interrupt until the processor has serviced the interrupt.
- For an edge-triggered interrupt, whether this transition occurs depends on the timing of the read of the ICCIAR relative to the detection of the reassertion of the interrupt. Otherwise the read of the ICCIAR causes transition C, possibly followed by transition A2.

Transition E1 or E2, remove active status

Occurs when software writes to the ICCEOIR.

12.4 Register Description

12.4.1 GIC Distributor interface register summary

Name	Offset	Size	Reset	Description
GICD_ICDDCR	0x000	W	0x0	Distributor Control Register
GICD_ICDICTR	0x004	W	-	Interrupt Controller Type Register
GICD_ICDIIDR	0x008	W	-	Distributor Implementer Identification Register
GICD_ICDISR	0x080	W	-	Interrupt Security Registers
-	-	-	-	reserved
GICD_ICDISER	0x100-0x17C	W	-	Interrupt Set-Enable Registers
GICD_ICDICER	0x180-0x1FC	W	-	Interrupt Clear-Enable Registers
GICD_ICDISPR	0x200-0x27C	W	0x0	Interrupt Set-Pending Registers
GICD_ICDICPR	0x280-0x2FC	W	0x0	Interrupt Clear-Pending Registers
GICD_ICDABR	0x300-0x37C	W	0x0	Active Bit Registers
-	-	-	-	reserved
GICD_ICDIPR	0x400-0x7F8	B	0x0	Interrupt Priority Registers
-	-	-	-	reserved
GICD_ICDIPTR	0x800-0x81C	B	-	Interrupt Processor Targets
-	-	-	-	reserved
GICD_ICDICFR	0xC00-0xCFC	W	-	Interrupt Configuration Registers
-	-	-	-	reserved
GICD_ICDSGIR	0xF00	W	-	Software Generated Interrupt Register

Notes:

Size: **B** – Byte (8 bits) access, **HW** – Half WORD (16 bits) access, **W** – WORD (32 bits) access

12.4.2 GIC Distributor interface detail register description

GICD_ICDDCR

Address: Operational Base+0x0

Distributor Control Register

Bit	Attr	Reset Value	Description
31:1	-	-	reserved
0	RW	0x0	Global enable for monitoring peripheral interrupt signals and forwarding pending interrupts to the CPU interface. 0 The GIC ignores all peripheral interrupt signals, and does not forward pending interrupts to the Cpu interface. 1 The GIC monitors the peripheral interrupt signals, and forwards pending interrupts to the Cpu interface.

GICD_ICDICTR

Address: Operational Base+0x4

Interrupt Controller Type Register

Bit	Attr	Reset Value	Description
31:11	-	-	reserved
10	R	0x1	Indicates whether the GIC implements the Security Extensions. 0 Security Extensions not implemented. 1 Security Extensions implemented
9:8	-	-	reserved
7:5	R	0x0	Indicates the number of implemented Cpu interface. The number of implemented Cpu interface is one more than the value of this field, for example if this field is 0b011, there are four Cpu interface. In this product ,only one cpu interface is implemented.
4:0	R	0x2	Indicates the maximum number of interrupts that the GIC supportsa. If the value of this field is N, the maximum number of interrupts is 32(N+1). The interrupt ID range is from 0 to one less than the number of IDs. For example: 0b00011 Up to 128 interrupt lines, interrupt IDs 0-127. The maximum number of interrupts is 1020 (0b11111).

GICD_ICDIIDR

Address: Operational Base+0x8

Distributor Implementer Identification Register

Bit	Attr	Reset Value	Description
31:24	R	0x0	product identifier.
23:20	-	-	reserved
19:16	R	0x0	variant number. Typically, this field is used to distinguish product variants, or major revisions of a product
15:12	R	0x0	revision number. Typically, this field is used to distinguish minor revisions of a product
11:0	R	0x0	Contains the JEP106 code of the company that implemented the GIC Distributor:a

			Bits [11:8] The JEP106 continuation code of the implementer. Bits [7] Always 0. Bits [6:0] The JEP106 identity code of the implementer.
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GICD_ICDISR

Address:Operational Base+0x80

Interrupt Security Registers

Bit	Attr	Reset Value	Description
31:0	RW	0x0	For each bit: 0 The corresponding interrupt is Secure. 1 The corresponding interrupt is Non-secure.

For interrupt ID N, when DIV and MOD are the integer division and modulo operations:

- the corresponding ICDISR number, M, is given by $M = N \text{ DIV } 32$
- the offset of the required ICDISR is $(0x080 + (4*M))$
- the bit number of the required Security status bit in this register is $N \text{ MOD } 32$.

GICD_ICDISER

Address:Operational Base+0x100

Interrupt Set-Enable Registers

Bit	Attr	Reset Value	Description
31:0	RW		For SPIs, for each bit: Reads 0 The corresponding interrupt is disabled. 1 The corresponding interrupt is enabled. Writes 0 Has no effect. 1 Enables the corresponding interrupt. A subsequent read of this bit returns the value 1.

For interrupt ID N, when DIV and MOD are the integer division and modulo operations:

- the corresponding ICDISER number, M, is given by $M = N \text{ DIV } 32$
- the offset of the required ICDISER is $(0x100 + (4*M))$
- the bit number of the required Set-enable bit in this register is $N \text{ MOD } 32$.

GICD_ICDICER

Address:Operational Base+0x180

Interrupt Clear-Enable Registers

Bit	Attr	Reset Value	Description
31:0	RW	0x0	For SPI, for each bit: Reads 0 The corresponding interrupt is disabled. 1 The corresponding interrupt is enabled. Writes 0 Has no effect. 1 Disables the corresponding interrupt. A subsequent read of this bit returns the value 0.

For interrupt ID N, when DIV and MOD are the integer division and modulo operations:

- the corresponding ICDICER number, M, is given by $M = N \text{ DIV } 32$
- the offset of the required ICDICER is $(0x180 + (4*M))$
- the bit number of the required Clear-enable bit in this register is $N \text{ MOD } 32$.

GICD_ICDISPR

Address:Operational Base+0x200
Interrupt Set-Pending Registers

Bit	Attr	Reset Value	Description
31:0	RW	0x0	<p>For each bit: Reads 0 The corresponding interrupt is not pending on any processor. 1</p> <ul style="list-style-type: none"> • For SGIs, the corresponding interrupt is pending on this processor. • For SPIs, the corresponding interrupt is pending on at least one processor. <p>Writes For SPIs: 0 Has no effect. 1 The effect depends on whether the interrupt is edge-triggered or level-sensitive:</p> <p>Edge-triggered Changes the status of the corresponding interrupt to:</p> <ul style="list-style-type: none"> • pending if it was previously inactive • active and pending if it was previously active. Has no effect if the interrupt is already pending. <p>Level sensitive If the corresponding interrupt is not pending, changes the status of the corresponding interrupt to:</p> <ul style="list-style-type: none"> • pending if it was previously inactive • active and pending if it was previously active. <p>If the interrupt is already pending:</p> <ul style="list-style-type: none"> • because of a write to the ICDISPR, the write has no effect • because the corresponding interrupt signal is asserted, the write has no effect on the status of the interrupt, but the interrupt remains pending if the interrupt signal is deasserted.

For interrupt ID N, when DIV and MOD are the integer division and modulo operations:

- the corresponding ICDISPR number, M, is given by $M = N \text{ DIV } 32$
- the offset of the required ICDISPR is $(0x200 + (4*M))$
- the bit number of the required Set-pending bit in this register is $N \text{ MOD } 32$.

GICD_ICDICPR

Address:Operational Base+0x280
Interrupt Clear-Pending Registers

Bit	Attr	Reset Value	Description
31:0	RW	0x0	For each bit: Reads

		<p>0 The corresponding interrupt is not pending on any processor 1</p> <ul style="list-style-type: none"> • For SGIs, the corresponding interrupt is pendinga on this processor. • For SPIs, the corresponding interrupt is pendinga on aleast one processor. <p>Writes For SPIs: 0 Has no effect. 1 The effect depends on whether the interrupt is edge-triggeredor level-sensitive:</p> <p>Edge-triggered Changes the status of the corresponding interrupto:</p> <ul style="list-style-type: none"> • inactive if it was previously pending • active if it was previously active and pending.Has no effect if the interrupt is not pending. <p>Level-sensitive If the corresponding interrupt is pendinga only because of a write to the ICDISPR, the write changes the status of the interrupt to:</p> <ul style="list-style-type: none"> • inactive if it was previously pending • active if it was previously active and pending.Otherwise the interrupt remains pending if the interrupt signal remains asserted.
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For interrupt ID N, when DIV and MOD are the integer division and modulo operations:

- the corresponding ICDICPR number, M, is given by $M = N \text{ DIV } 32$
- the offset of the required ICDICPR is $(0x280 + (4*M))$
- the bit number of the required Set-pending bit in this register is $N \text{ MOD } 32$.

GICD_ICDABR

Address:Operational Base+0x300

Active Bit Registers

Bit	Attr	Reset Value	Description
31:0	R		For each bit: 0 Corresponding interrupt is not active. 1 Corresponding interrupt is active.

For interrupt ID N, when DIV and MOD are the integer division and modulo operations:

- the corresponding ICDABR number, M, is given by $M = N \text{ DIV } 32$
- the offset of the required ICDABR is $(0x300 + (4*M))$
- the bit number of the required Active bit in this register is $N \text{ MOD } 32$.

GICD_ICDIPR

Address:Operational Base+0x400

Interrupt Priority Registers

Bit	Attr	Reset Value	Description
7:0	RW	0x0	The lower the value, the greater the priority of the corresponding interrupt.

For interrupt ID N:

- the corresponding ICDIPR number, M, is given by $M = N$
- the offset of the required ICDIPR is $(0x400 + M)$

GICD_ICDIPTR

Address: Operational Base+0x800

Interrupt Processor Targets Registers

Bit	Attr	Reset Value	Description
7:0	RW	0x1	This register is not used. As in our product ,there is only one processor.

GICD_ICDICFR

Address: Operational Base+0xc00

Interrupt Configuration Registers

Bit	Attr	Reset Value	Description
2F+1	RW	0x0	F=0,1,2,3....15 The encoding is: 0 Corresponding interrupt is level-sensitive. 1 Corresponding interrupt is edge-triggered.

For interrupt ID N, when DIV and MOD are the integer division and modulo operations:

- the corresponding ICDICFR number, M, is given by $M = N \text{ DIV } 16$
- the offset of the required ICDIPTR is $(0xC00 + (4*M))$
- the required Priority field in this register, F, is given by $F = N \text{ MOD } 16$, where field 0 refers to register bits [1:0], field 1 refers to bits [3:2], and so on, up to field 15 refers to bits [31:30]

GICD_ICDSGIR

Address: Operational Base+0xf00

Software Generated Interrupt Register

Bit	Attr	Reset Value	Description
31:26	-	-	reserved
25:24	W	0x0	0b00 Send the interrupt to the Cpu interface specified in the CPUTargetList field. 0b01 Send the interrupt to all Cpu interface except the CPU interface that requested the interrupt. 0b10 Send the interrupt only to the CPU interface that requested the interrupt. 0b11 Reserved
23:16	W	0x0	When TargetList Filter = 0b00, defines the Cpu interface the Distributor must send the interrupt to. Each bit of CPUTargetList[7:0] refers to the corresponding CPU interface, for example CPUTargetList[0] corresponds to CPU interface 0. Setting a bit to 1 sends the interrupt to the corresponding interface.
15	W	0x0	If the GIC implements the Security Extensions, this field is writable only using a Secure access.

			<p>Any Non-secure write to the ICDSGIR issues an SGI only if the specified SGI is programmed as Non-secure, regardless of the value of bit [15] of the write.</p> <p>Specifies the required security value of the SGI:</p> <ul style="list-style-type: none"> 0 Send the SGI specified in the SGINTID field to a specified CPU interface only if the SGI is configured as Secure on that interface. 1 Send the SGI specified in the SGINTID field to a specified Cpu interface only if the SGI is configured as Non-secure on that interface
14:4	-	-	reserved
3:0	W	0x0	The Interrupt ID of the SGI to send to the specified Cpu interface. The value of this field is the Interrupt ID, in the range 0-15, for example a value of 0b0011 specifies Interrupt ID 3

12.4.3 GIC CPU interface register summary

Name	Offset	Size	Reset Value	Description
GICC_ICCICR	0x00	W	0x0	CPU Interface Control Register
GICC_ICCPMR	0x04	W	0x0	Interrupt Priority Mask Register
GICC_ICCBPR	0x08	W	0x0	Binary Point Register
GICC_ICCIAR	0x0C	W	0x3ff	Interrupt Acknowledge Register
GICC_ICCEOIR	0x10	W	-	End of Interrupt Register
GICC_ICCRPR	0x14	W	0xff	Running Priority Register
GICC_ICCHPIR	0x18	W	0x3ff	Highest Pending Interrupt Register
GICC_ICCABPR	0x1C	W	0x0	Aliased Binary Point Register
GICC_ICCIIDR	0xFC	W	0x0	CPU Interface Identification Register

Notes:

Size: **B** – Byte (8 bits) access, **HW** – Half WORD (16 bits) access, **W** – WORD (32 bits) access

12.4.4 GIC CPU interface detail register description

GICC_ICCICR

Address: Operational Base+0x0
CPU Interface Control Register

Bit	Attr	Reset Value	Description
31:5	-	-	reserved
4	RW	0x0	<p>Controls whether the CPU interface uses the Secure or Non-secure Binary Point Register for preemption.</p> <p>0</p> <p>To determine any preemption, use:</p> <ul style="list-style-type: none"> • the Secure Binary Point Register for Secure

			<p>interrupts</p> <ul style="list-style-type: none"> the Non-secure Binary Point Register for Non-secure interrupts. <p>1 To determine any preemption use the Secure Binary Point Register for both Secure and Non-secure interrupts.</p>
3	RW	0x0	<p>Controls whether the GIC signals Secure interrupts to a target processor using the FIQ or the IRQ signal.</p> <p>0 Signal Secure interrupts using the IRQ signal.</p> <p>1 Signal Secure interrupts using the FIQ signal. The GIC always signals Non-secure interrupts using the IRQ signal.</p>
2	RW	0x0	<p>Controls whether a Secure read of the ICCIAR, when the highest priority pending interrupt is Non-secure, causes the CPU interface to acknowledge the interrupt.</p> <p>0 If the highest priority pending interrupt is Non-secure, a Secure read of the ICCIAR returns an Interrupt ID of 1022. The read does not acknowledge the interrupt, and the pending status of the interrupt is unchanged.</p> <p>1 If the highest priority pending interrupt is Non-secure, a Secure read of the ICCIAR returns the Interrupt ID of the Non-secure interrupt. The read acknowledges the interrupt, and the status of the interrupt becomes active, or active and pending.</p>
1	RW	0x0	<p>An alias of the Enable bit in the Non-secure ICCICR. This alias bit means Secure software can enable the signalling of Non-secure interrupts.</p> <p>0 Disable signalling of Non-secure interrupts.</p> <p>1 Enable signalling of Non-secure interrupts</p>
0	RW	0x0	<p>Global enable for the signalling of Secure interrupts by the Cpu interface to the connected processors.</p> <p>0 Disable signalling of Secure interrupts.</p> <p>1 Enable signalling of Secure interrupts</p>

GICC_ICCPMR

Address: Operational Base+0x4

Interrupt Priority Mask Register

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:0	RW	0x0	The priority mask level for the CPU interface. If the priority of an interrupt is higher than the value indicated by this field, the interface signals

			the interrupt to the processor. If the GIC supports fewer than 256 priority levels then some bits are RAZ/WI, as follows: 128 supported levels Bit [0] = 0. 64 supported levels Bit [1:0] = 0b00. 32 supported levels Bit [2:0] = 0b000. 16 supported levels Bit [3:0] = 0b0000
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GICC_ICCBPR

Address: Operational Base+0x8

Binary Point Register

Bit	Attr	Reset Value	Description
31:3	-	-	reserved
2:0	RW	0x0	The value of this field controls how the 8-bit interrupt priority field is split into a group priority field, used to determine interrupt preemption, and a subpriority field.

GICC_ICCIAR

Address: Operational Base+0xc

Interrupt Acknowledge Register

Bit	Attr	Reset Value	Description
31:13	-	-	reserved
12:10	RO	0x0	For SGIs in a multiprocessor implementation, this field identifies the processor that requested the interrupt. It returns the number of the CPU interface that made the request, for example a value of 3 (0b011) means the request was generated by a write to the IDCSFGIR on CPU interface 3. For all other interrupts this field is RAZ.
9:0	RO	0x0	The interrupt ID.

GICC_ICCEOIR

Address: Operational Base+0x10

End of Interrupt Register

Bit	Attr	Reset Value	Description
31:13	-	-	reserved
12:10	WO	0x0	On a multiprocessor implementation, on completion of the processing of an SGI, this field contains the CPUID value from the corresponding ICCIAR access.
9:0	WO	0x0	The ACKINTID value from the corresponding ICCIAR access.

GICC_ICCRPR

Address: Operational Base+0x14

Running Priority Register

Bit	Attr	Reset Value	Description
31:8	-	-	reserved
7:0	RO	0x0	The priority value of the highest priority interrupt that is active on the CPU interface.

GICC_ICCABPR

Address:Operational Base+0x18

Aliased Binary Point Register

Bit	Attr	Reset Value	Description
31:3	-	-	reserved
2:0	RW	0x0	Provides an alias of the Non-secure ICCBPR.

GICC_ICCHPIR

Address:Operational Base+0x1c

Highest Pending Interrupt Register

Bit	Attr	Reset Value	Description
31:10	-	-	reserved
9:0	R	0x0	The interrupt ID of the highest priority pending interrupt.

GICC_ICCIIDR

Address:Operational Base+0xfc

CPU Interface Identification Register

Bit	Attr	Reset Value	Description
31:20	R	0x0	An IMPLEMENTATION DEFINED product identifier.
19:16	R	0x0	For an implementation that complies with this specification, the value is 0x1
15:12	R	0x0	An IMPLEMENTATION DEFINED revision number for the CPU interface.
11:0	R	0x0	Contains the JEP106 code of the company that implemented the GIC CPU interface: b Bits [11:8] The JEP106 continuation code of the implementer. Bit [7] Always 0. Bits [6:0] The JEP106 identity code of the implementer.

12.5 Interface Description

Both distributor interface and cpu interface are secure accessed only after reset,Register inside the CPU L1 AXI interconnect needs to be configured to change to non-secure access.

When the tie_off signal cfgisable is HIGH, it enhances the security of the GIC by preventing write accesses to security-critical configuration registers. This signal is low after reset, it can be configured through TZPC registers.

12.6 Application Notes

12.6.1 General handling of interrupts

The GIC operates on interrupts as follows:

1. The GIC determines whether each interrupt is enabled. An interrupt that is not enabled has no further effect on the GIC.(Enables an interrupt by writing to the appropriate ICDISER bit, disables an interrupt by writing to the appropriate ICDICER bit)

2. For each enabled interrupt that is pending, the Distributor determines the targeted processor.
3. For processor, the Distributor determines the highest priority pending interrupt, based on the priority information it holds for each interrupt, and forwards the interrupt to the CPU interface.
4. The CPU interface compares the interrupt priority with the current interrupt priority for the processor, determined by a combination of the Priority Mask Register, the current preemption settings, and the highest priority active interrupt for the processor. If the interrupt has sufficient priority, the GIC signals an interrupt exception request to the processor.
5. When the processor takes the interrupt exception, it reads the ICCIAR in its CPU interface to acknowledge the interrupt. This read returns an Interrupt ID that the processor uses to select the correct interrupt handler. When it recognizes this read, the GIC changes the state of the interrupt:
 - if the pending state of the interrupt persists when the interrupt becomes active, or if the interrupt is generated again, from pending to active and pending.
 - otherwise, from pending to active
6. When the processor has completed handling the interrupt, it signals this completion by writing to the ICCEOIR in the GIC

Generating an SGI

A processor generates an SGI by writing to an ICDSGIR.

12.6.2 Interrupt prioritization

Software configures interrupt prioritization in the GIC by assigning a priority value to each interrupt source. Priority values are 8-bit unsigned binary. In this product, GIC implements 64 priority levels. So only the highest 6 bits are valid, the lower 2 bits read as zero.

In the GIC prioritization scheme, lower numbers have higher priority, that is, the lower the assigned priority value the higher the priority of the interrupt. The highest interrupt priority always has priority field value 0.

The ICDIPRs hold the priority value for each supported interrupt. To determine the number of priority bits implemented write 0xFF to an ICDIPR priority field and read back the value stored.

Preemption

A CPU interface supports forwarding of higher priority pending interrupts to a target processor before an active interrupt completes. A pending interrupt is only forwarded if it has a higher priority than all of:

- the priority of the highest priority active interrupt on the target processor, the running priority for the processor, see Running Priority Register (ICCRPR) .
- the priority mask, see Priority masking.
- the priority group, see Priority grouping.

Preemption occurs at the time when the processor acknowledges the new interrupt, and starts to service it in preference to the previously active interrupt or the currently running process. When this occurs, the initial active interrupt is said to have been preempted. Starting to service an interrupt while another

interrupt is still active is sometimes described as interrupt nesting.

Priority masking

The ICCPMR for a CPU interface defines a priority threshold for the target processor, see Interrupt Priority Mask Register. The GIC only signals pending interrupts with a higher priority than this threshold value to the target processor. A value of zero, the register reset value, masks all interrupts to the associated processor.

The GIC always masks an interrupt that has the largest supported priority field value. This provides an additional means of preventing an interrupt being signalled to any processor.

Priority grouping

Priority grouping splits each priority value into two fields, the group priority and the subpriority fields. The GIC uses the group priority field to determine whether a pending interrupt has sufficient priority to preempt a currently active interrupt.

The binary point field in the ICCBPR controls the split of the priority bits into the two parts. This 3-bit field specifies how many of the least significant bits of the 8-bit interrupt priority field are excluded from the group priority field, as following table shows.

Binary point value	Group priority field	Subpriority field	Field with binary point
0	[7:1]	[0]	ggggggg.s
1	[7:2]	[1:0]	gggggg.ss
2	[7:3]	[2:0]	gggggsss
3	[7:4]	[3:0]	gggg.ssss
4	[7:5]	[4:0]	gg.ssssss
5	[7:6]	[5:0]	g.ssssss
6	[7]	[6:0]	.ssssssss
7	No preemption	[7:0]	

Where multiple pending interrupts share the same group priority, the GIC uses the subpriority field to resolve the priority within a group.

12.6.3 The effect of the Security Extensions on interrupt handling

If a GIC CPU interface implements the Security Extensions, it provides two interrupt output signals, IRQ and FIQ:

- The CPU interface always uses the IRQ exception request for Non-secure interrupts
- Software can configure the CPU interface to use either IRQ or FIQ exception requests for Secure interrupts.

Security Extensions support

Software can detect support for the Security Extensions by reading the ICDICTR.SecurityExtn bit, see Interrupt Controller Type Register (ICDICTR). Secure software makes Secure writes to the ICDISRs to configure each interrupt as Secure or Non-secure, see Interrupt Security Registers (ICDISRn).

In addition:

- The banking of registers provides independent control of Secure and

Non-secure interrupts.

- The Secure copy of the ICCICR has additional fields to control the processing of Secure and Non-secure interrupts, see CPU Interface Control Register (ICCICR) These fields are:
 - the SBPR bit, that affects the preemption of Non-secure interrupts.
 - the FIQEn bit, that controls whether the interface signals Secure interrupts to the processor using the IRQ or FIQ interrupt exception requests.
 - the AckCtl bit, that affects the acknowledgment of Non-secure interrupts.
 - the EnableNS bit, that controls whether Non-secure interrupts are signaled to the processor, and is an alias of the Enable bit in the Non-secure ICCICR.
- The Non-secure copy of the ICCBPR is aliased as the ICCABPR, see Aliased Binary Point Register (ICCABPR). This is a Secure register, meaning it is only accessible by Secure accesses.

Effect of the Security Extensions on interrupt acknowledgement

When a processor takes an interrupt, it acknowledges the interrupt by reading the ICCIAR. A read of the ICCIAR always acknowledges the highest priority pending interrupt for the processor performing the read.

If the highest priority pending interrupt is a Secure interrupt, the processor must make a Secure read of the ICCIAR to acknowledge it.

By default, the processor must make a Non-secure read of the ICCIAR to acknowledge a Non-secure interrupt. If the AckCtl bit in the Secure ICCICR is set to 1 the processor can make a Secure read of the ICCIAR to acknowledge a Non-secure interrupt.

If the read of the ICCIAR does not match the security of the interrupt, taking account of the AckCtl bit value for a Non-secure interrupt, the ICCIAR read does not acknowledge any interrupt and returns the value:

- 1022 for a Secure read when the highest priority interrupt is Non-secure
- 1023 for a Non-secure read when the highest priority interrupt is Secure.

12.6.4 The effect of Security Extensions on interrupt priority

If the GIC supports the Security Extensions:

- Secure software must program the ICDISRs to configure each supported interrupt as either Secure or Non-secure, see Interrupt Security Registers (ICDISRn).
- the GIC provides Secure and Non-secure views of the interrupt priority settings

Software views of interrupt priority

When a processor reads the priority value of an interrupt, the GIC returns either the Secure or the Non-secure view of that value, depending on whether the access is Secure or Non-secure. This section describes the two views of interrupt priority, and the relationship between them.

In this product, 64 priority levels are implemented.

F	E	D	C	B	A	0	0
---	---	---	---	---	---	---	---

Fig. 12- 3Secure view of the priority field for a Secure interrupt

Fig 12-3 shows the Secure view of a priority value field for a Secure interrupt.

A-F is the priority value. The low-order bits of the priority fields are RAZ/WI

E	D	C	B	A	0	0	0
---	---	---	---	---	---	---	---

Fig. 12- 4 Non-secure view of the priority field for a Non-secure interrupt

Fig 12-4 shows the Non-secure view of a priority value field for a Non-secure interrupt. A-E is the priority value. The low-order bits of the priority fields are RAZ/WI

The Non-secure view of a priority value does not show how the value is stored in the Distributor. Taking the value from a Non-secure write to a priority field, before storing the value the Distributor:

- right-shifts the value by one bit
- sets bit [7] of the value to 1.

This translation means the priority value for the Non-secure interrupt is in the top half of the possible value range, meaning the interrupt priority is in the bottom half of the priority range.

A Secure read of the priority value for a Non-secure interrupt returns the value stored in the distributor. Fig12-5 shows this Secure view of the priority value field for a Non-secure interrupt that has had its priority value field set by a Non-secure access, or has had a priority value with bit [7] == 1 set by a Secure access:

1	E	D	C	B	A	0	0
---	---	---	---	---	---	---	---

Fig. 12- 5 Secure read of the priority field for a Non-secure interrupt

Chapter 13 DMC (Dynamic Memory Interface)

13.1 Overview

The DMC includes two section: dynamic ram protocol controller(PCTL) and phy controller (PHYCTL).

The PCTL SoC application bus interface supports a lowest-latency native application interface (NIF). To maximize data transfer efficiency, NIF commands transfer data without flow control. To simplify command processing, the NIF accepts addresses in rank, bank, row, column format.

The PHYCTL provides control features to ease the customer implementation of digitally controlled features of the PHY such as initialization, DQS gate training, and programmable configuration controls. The PHYCTL has built-in self test features to provide support for production testing of the compatible PHY. It also provides a DFI 2.1 interface to the PHY.

The DMC supports the following features:

- Complete, integrated, single-vendor DDR2, DDR3, mDDR, LPDDR2 solution .
- DFI 2.1 interface compatibility
- Up to 1066 Mbps in 1:1 frequency ratio, using a 533MHz controller clock and 533MHz memory clock.
- Support for x8, x16, and x32 memories, for a total memory data path width of up to 72 bits
- Up to 2 memory ranks; devices within a rank tie to a common chip select
- Up to 8 open memory banks, maximum of eight per rank
- Per-NIF transaction controllable bank management policies: open-page, close-page
- Low area, low power architecture with minimal buffering on the data, avoiding duplication of storage resources within the system
- PCTL NIF slave interface facilitates easy integration with an external scheduler or standard on-chip buses
- Efficient DDR protocol implementation with in-order column (Read and Write) commands and out- of-order Activate and Precharge commands
- Three clock cycles best case command latency (best case is when a command is to an open page and the shift array in the PCTL is empty).
 - 1T or 2T memory command timing
 - Automatic clock stop, power-down and self-refresh entry and exit. Clock stop is mDDR/LPDDR2 only
- Software and hardware driven self-refresh entry and exit
- Programmable memory initialization
- Partial population of memories, where not all DDR byte lanes are populated with memory chips
- Programmable per rank memory ODT (On-Die Termination) support for reads and writes
- APB interface for controller software-accessible registers

- Programmable data training interface:
Assists in training of the data eye of the memory channel
Provides a method for testing large sections of memory
- Support for industry standard UDIMMs (Unbuffered DIMMs) and RDIMMs (Registered DIMMs)
- Automatic DQS gate training and drift compensation
- At-speed built-in-self-test (BIST) loopback testing on both the address and data channels for DDR PHYs
- PHY control and configuration registers
- Optional, additional JTAG interface to configure registers
- DFI 2.1 interface

13.2 Block Diagram

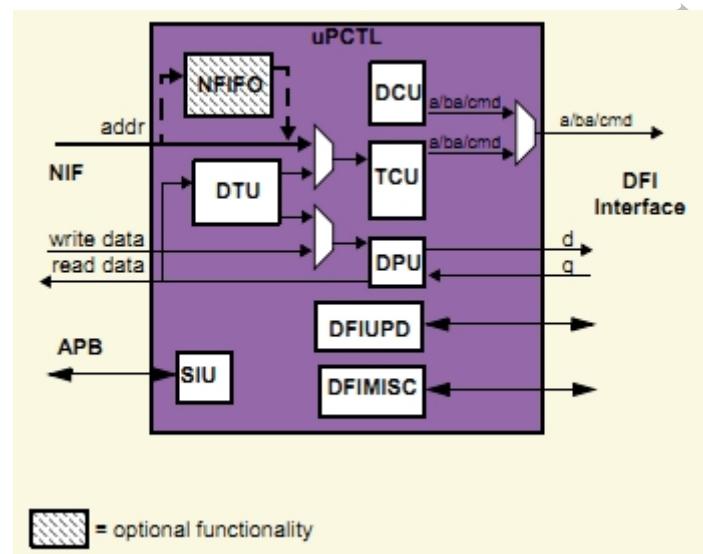
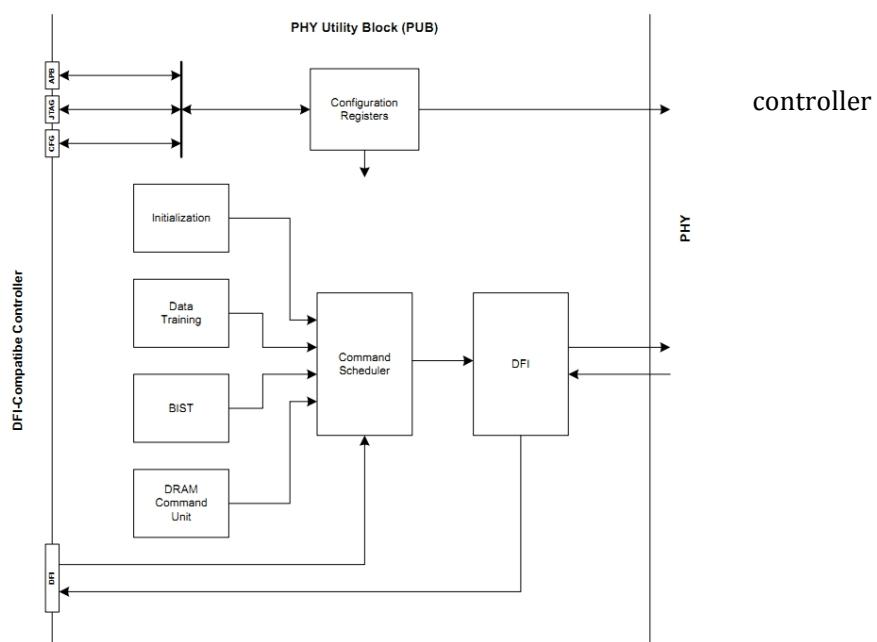


Fig. 13-1 Protocol controller architecture

Fig. 13-2 PHY architecture



13.3 Function description

PCTL operations are defined in terms of the current state of the Operational State Machine. Software can move PCTL in any of the operational states by issuing commands via the SCTL register. Transitions from one operational state to the other occur pass through a “transitional” state. Transitional states are exited automatically by the PCTL after all the necessary actions required to change operational state have been completed. The current operational state of PCTL is reported by the STAT register and is also available from the p_ctl_stat output.

PCTL supports the following operational states:

- Init_mem - This state is the default state entered after reset. All writable registers can be programmed. While in this state software can program PCTL and initialize the PHY and the memories. The memories are not refreshed and data that has previously been written to the memories may be lost as a result. The Init_mem state is also used when it is desirable to stop any automatic PCTL function that directly affects the memories, like Power Down and Refresh, or when a software reset of the memory subsystem has to be executed.
- Config - This state is used to suspend temporarily the normal NIF traffic and allow software to reprogram PCTL and memories if necessary, while still keeping active the periodic generation of Refresh cycles to the memories. Power Down entry and exit sequences are possible while in Config state.
- Access - This is the operational state where NIF transactions are accepted by the PCTL and converted into memory read and writes. None of the registers can be programmed except SCFG, SCTL, ECCCLR and DTU* registers.
- Low_power - Memories are in self refresh mode. The PCTL does not generate refresh cycles while in this state.

Access and Low_power states can also be entered and exited by the hardware low power signals (c_ *). In case of conflicting software and hardware low-power commands, the resulting operational state taken by the controller can be either one of the two conflicting requests.

Figure 13-3 illustrates the operational and transitional states.

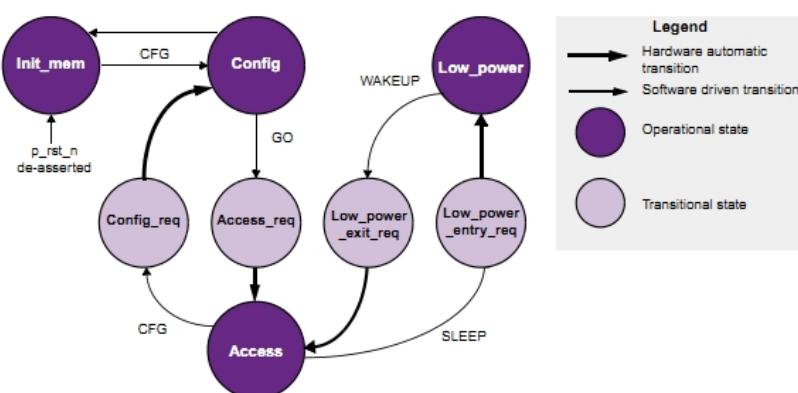


Fig. 13-3 Protocol controller architecture

The PHYCTL provides control features to ease the customer implementation of digitally controlled PHY features such as read DQS training, data eye training, output impedance calibration, and so on. The PHTCTL has built-in self test features to provide support for production testing of PHY. It also provides a DFI 2.1 interface to the PHY. The PHYCTL performs, in sequence, various tasks required by the PHY before it can commence normal DDR operations. SDRAM memory read/write access through the DDR PHY is primarily through a DFI 2.1 interface on the PHYCTL. Therefore, the memory controller used with the PHY must be DFI 2.1 compatible.

Access to the PHYCTL internal control features and registers is through a dedicated configuration port, which can be either APB or CFG (generic configuration interface). An optional JTAG interface can also be compiled in as an additional second configuration port to co-exist with either the APB or CFG main configuration ports. The PHYCTL is driven off two clocks, the controller clock (ctl_clk) and the configuration clock pclk for an APB interface.

The controller clock is the same clock driving the memory controller and will be the same frequency as the SDRAM clock (ck). The configuration clock can run at a frequency equal to or less than the controller clock. The configuration clock drives all non-DDR timing logic, such as configuration registers, PHY initialization, output impedance, and so on.

13.4 DDR PHY

13.4.1 DDR PHY Overview

In order to facilitate robust system timing and ease of use, DMC interface and control architecture utilizes a mixture of soft-IP and hard-IP design elements. The main control logic (Memory Controller) is supplied as soft-IP. The PHY is comprised of hard-IP components that include double-data rate InterfaceTiming Modules (ITM), input and output path DLLs, and application-specific SSTL I/Os.

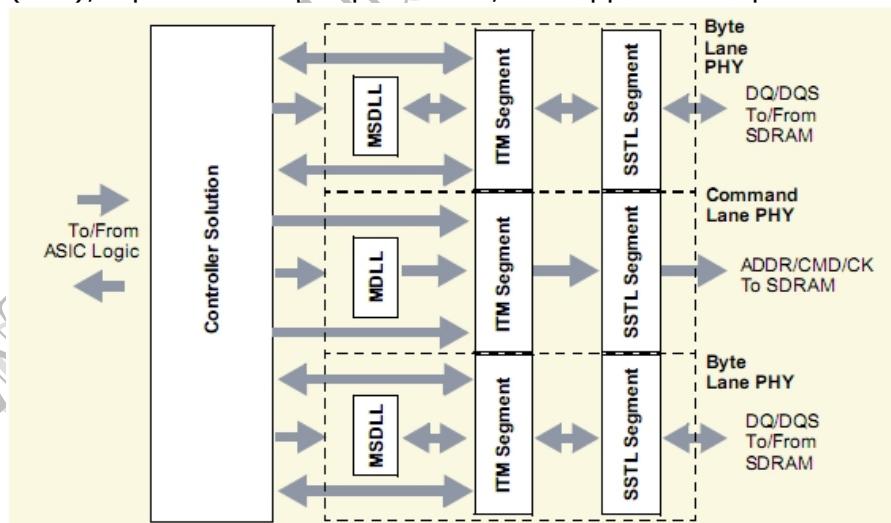


Fig. 13-4 DDR PHY architecture

In order to maximize system timing margins on the command/write path, inputs to the SDRAM are provided with the clock or data strobe centered in the associated data eye. The ITM components perform timing translation for the various signal groups of the interface. The hardened ITM approach ensures minimal pin to pin skew while allowing optimal circuit design for drive and capture circuitry. A DLL is utilized to facilitate the clock centering. In the Command Lane, a master DLL (MDLL) is utilized. In the Byte Lane, the master portion of a master/slave DLL macrocell (MSDLL) is utilized.

On the read path, read data from the SDRAM is arriving from the SDRAM edge aligned with the data strobes. In order to maintain maximum system timing margins on the input path, the data strobes are translated to the center of the data eye. The MSDLL macrocell associated with each Byte Lane contains a master DLL and 2 slave DLLs (mirror delay lines). The slave DLL portion of the MSDLL is utilized to facilitate the clock centering. DQS and DQS_b strobe inputs each utilize one of these slave DLL functions. The captured double data rate inputs are then converted to single data rate and passed onto the DDR Controller RTL logic. The ITM facilitates both data capture and DDR to SDR conversion.

The physical interface between the DDR controller and DDR SDRAMs uses DDR-specific SSTL I/O buffers with programmable on-die termination (ODT). These I/Os operate at either 1.8V for LPDDR/DDRII interfacing (SSTL_18).

DMC interface and control architecture follows a common signal grouping philosophy. A Byte Lane is a complete eight-bit data unit consisting of the associated DQ, DM, and DQS/DQS_b signals. A 32-bit system would consist of four Byte Lanes. A Command Lane is a complete command and address unit including also clock signals. There would normally be only one Command Lane in a particular DDR SDRAM interface. All clock and data signals relative to a Lane, either Byte or Command, are isolated to within that Lane only. Timing critical clock and data signals do not traverse between Lanes. Implementation of a memory interface involves placing the Command Lane components, placing the Byte Lane components, and standard synthesis/place and route to complete the design.

Each SSTL cell communicating with the SDRAM has an associated ITM component. The ITM library consists of individual components designed specifically for signal groups of address and command, data & data mask, and data strobes. In order to ensure low pin to pin skews and facilitate ease of implementation, the ITM components are tileable. DLL output clock distribution is embedded within the ITM components.

13.4.2 Lane-Based Architecture

Byte Lane PHY

The data bus interface to the external memory is organized into self-contained units referred to herein as Byte Lanes. The external memory components are designed to support Byte Lanes for optimal system timing. The partitioning of the data word into discrete Byte Lanes allows pin to pin skew to be managed across a much smaller group of signals than would typically be required.

All components of the Byte Lane PHY are designed to permit connectivity by abutment. The ITM connects by abutment to the SSTL I/O, and the DLL connects by abutment to the ITM.

The SDRAM contains data strobes associated with each 8 bits of data and there is a timing skew allowance between the main clock signal to the SDRAM and its data strobe inputs during a Write command (tDQSS). 8bit memory components provide a single DQS.

A Byte Lane consists of the following I/O slots:

- ◊ 8 data bits (DQ)
- ◊ data strobe bits (DQS / DQS_b)
- ◊ 1 data mask bit (DM)
- ◊ I/O power and ground cells
- ◊ Core power and ground cells

Each functional I/O slot has an associated ITM module, including DQ, DM, and DQS/DQS_b. The ITMs provide a mechanism for monitoring read timing drift, which can be used to adjust timing to maintain optimum system margins. Drift

analysis and compensation is performed by the controller on a per Byte Lane basis. The ITM components contain the functions to monitor DQS drift and permit timing adjustment, the controller provides the analysis and control for these functions. These functions operate dynamically for each data bit of every user-issued Read command. There are no overhead penalties in channel bandwidth or utilization incurred by the use of these functions.

The memory interface (PHY) architecture is based on the concept of independent, but related, signal groups to provide the highest level of system timing performance. In order to maintain robust system timing, all clock and data signals relevant to a Byte Lane remain within that Byte Lane. These signals are not shared between other Byte Lanes or between a Byte Lane and a Command Lane. Alternate approaches require clock distribution networks that span the full length of the interface including all address, command, and data signals. These large clock distribution networks are difficult for the user to design and implement, and add an additional component of pin to pin skew to the critical timing budget.

A DLL macrocell (MSDLL) consisting of a master DLL and 2 slave DLLs (mirror delay lines) is utilized at each Byte Lane to facilitate optimal PHY timing for drive and capture of DDR data streams, and allows the Lanes to be independent. The master DLL section provides outputs for DDR data stream creation to the SDRAMs and acts as a reference for the slave delay line sections. The slave delay line sections translate the incoming DQS/DQS_b into the center of the read data eye to maximize read system timing margins.

The user is permitted to fine tune the relationship of the DQS and DQ signals to maximize read system timing margin. The DLL includes adjustability of the slave delay lines for the DQS and DQS_b signals, which provide byte-wide timing adjustments. The ITMs include adjustability of the read DQS/DQS_b strobe timing, which provides byte-wide timing adjustments. The ITMs include adjustability of the read DQ signal timing, which provides per-bit timing adjustability. To permit Lane-independent timing adjustments, DLL adjustment bits are provided by the controller per Byte Lane and ITM adjustment bits are provided per bit.

DMC interface and control solution allows memory systems with a word width narrower than the design. Our system is designed with a 32 bit data width and it can then be utilized with either 16 bit or 32 bit memory systems. The controller contains register settings to allow the desired operational mode to be set in the final device.

The DDR-specific SSTL I/Os include programmable ODT and output impedance selection. The ODT and output impedances can be dynamically calibrated to compensate for variations in voltage and temperature. The ODT feature can be disabled by the controller. When ODT is enabled by the controller, the SSTL I/O automatically enables its internal ODT circuitry when in input mode and disable this circuitry when in output mode, as determined by the output enable signal. The initial programming and subsequent calibration of the ODT and output impedance is achieved through the use of an impedance control loop that can be triggered to calibrate the ODT and output impedance values at the I/Os based on the desired impedance value when compared to an precision external resistor. All the necessary pieces of the impedance control loop are included in the SSTL I/O library.

There are four Byte Lanes in our chip of 32 bit memory system.

Command Lane PHY

The control and address interface to the external memory is organized into a self-contained unit referred to herein as a Command Lane. DMC interface

contains a single Command Lane and four Byte Lanes.

All components of the Command Lane PHY are designed to permit connectivity by abutment. The ITM connects by abutment to the SSTL I/O, and the DLL connects by abutment to the ITM.

A typical Command Lane consists of the following I/O slots:

- ✧ Memory clocks (CK/CK_b)
- ✧ Command signals (RAS_b, CAS_b, WE_b)
- ✧ 1 or more clock enable (CKE)
- ✧ 1 or more on-die termination (ODT)
- ✧ 2 chip select (CS_b)
- ✧ 3 bank address (BA)
- ✧ 16 row/column address (A)
- ✧ I/O power and ground cells
- ✧ Core power and ground cells

The system clock input is used to provide the source clock for the memory interface. Memory controller supports 2 SDRAM ranks. There is one CKE, ODT, and CS_b signal provided for each rank.

Each functional I/O slot has an associated ITM module, with exception of the system clock input. A master DLL (MDLL) is utilized with the Command Lane to facilitate optimal PHY timing for drive of DDR data streams, and allows the Lane to be independent. The DLL macrocells provide two 0 degree phase outputs, one which can be used to drive the controller logic. The Command Lane MDLL is used for this purpose.

To permit Lane-independent timing adjustments, DLL and ITM adjustment bits are provided by the controller separately for Command and Byte Lanes.

13.4.3 Master DLL(MDLL)

Master DLL for DDRII, and LPDDR applications is a Delay Locked Loop that takes an input reference clock (clk_in) and generates four clock outputs, each delayed in quarter clock cycle (90°) increments. These four clock phases (clk_0, clk_90, clk_180, clk_270) can be generated with very high accuracy and low jitter across a wide range of frequencies.

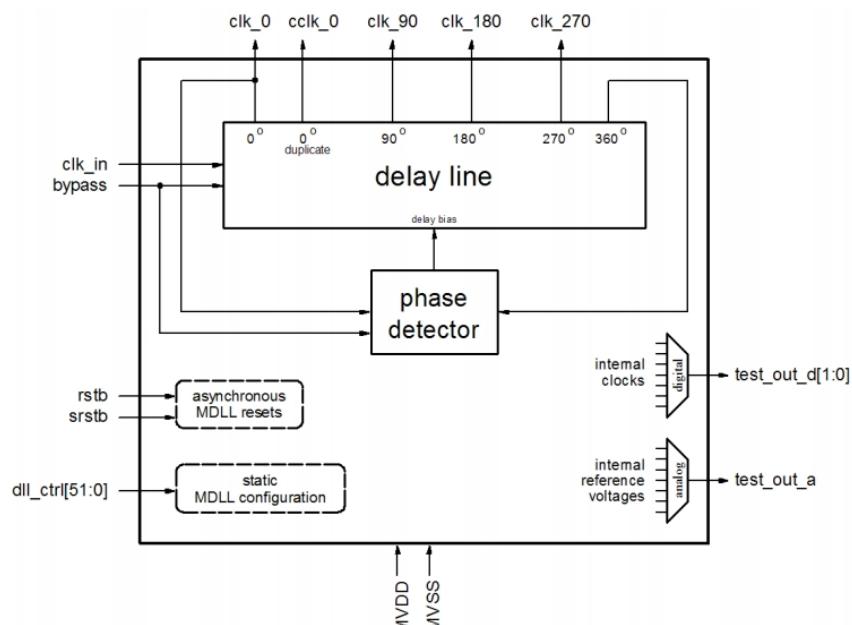


Fig. 13-5 DDR PHY master DLL architecture diagram
A number of test modes and configuration settings are included:

- ✧ A bypass mode shuts down all analog circuitry, and directly buffers the input clock and strobes with appropriate delays and inversions to the output clocks and strobes. This mode can be used for low speed functional or IDDQ testing.
- ✧ A digital test output (test_out_d) provides direct observability of several internal reference clock and timing nodes.
- ✧ An analog test output (test_out_a) provides direct observability of several internal reference voltages.

Master DLL Control for Trim and Test

The performance and testing of the MDLL can be accessed through the dll_ctrl bus.

Table 13-1 DDR PHYtrim and test MDLL control

Static Input	Field	Description
dll_ctrl	[1:0]	Reserved
	[4:2]	ipump_trm[2:0]
	[5]	test_ctrl_en
	[8:6]	test_ctrl_d[2:0]
	[10:9]	test_ctrl_a[1:0]
	[11]	Reserved
	[14:12]	bias_trm[2:0]
	[19,15]	fdtrm[1:0]
	[22:20]	bias_trm[6:4]
	[23]	bps200
	[28:24]	Reserved
	[29]	Reserved
	[37:30]	Reserved
	[43:38]	fb_trm[5:0]
	[49:44]	Reserved
	[50]	test_hizb_a
	[51]	Reserved

Charge Pump Current Trim:

Table 13-2 charge pump current trim in dll_ctrl

Field	Setting	Function	Suggested Default
ipump_trm[2:0]	000	Maximum current	000
	111	Minimum current	

Digital Test Control:

Table 13-3 DLL digital test control in dll_ctrl

test_ctrl_en	test_ctrl_d[2:0]	Function	Suggested Default
0	xxx	digital test outputs disabled (drive '0')	0,000
1	000	0° output clock (clk_0)	
1	001	90° output clock (clk_90)	
1	010	180° output clock (clk_180)	
1	011	270° output clock (clk_270)	

1	100	360° internal clock (clk_360_int)	
1	101	Speed-up pulse (spdup)	
1	110	Slow-down pulse (slwdn)	
1	111	Asic output clock (cclk_0)	

Analog Test Control:

Table 13- 4DLL analog test control in dll_ctrl

test_hizb_a	test_ctrl_en	test_ctrl_a [1:0]	Function	Suggested Default
0	x	xx	Tri-state	0,0,00
1	0	xx	MVSS	
1	1	00	Filter output (Vc)	
1	1	01	Replica bias output for NMOS (Vbn)	
1	1	10	Replica bias output for PMOS (Vbp)	
1	1	11	MVDD	

Bias Generator Trim:

The bias generator trim capability can be used to adjust the behavior of the bias voltages being supplied to the delay line. Characteristics of the DLL that may warrant an adjustment of this trim value include the inability to lock due to a slow clock (suggest decreasing Vc adjust), inability to lock due to fast clock (suggest increasing Vc adjust) and increase noise margin on bias voltages (suggest decreasing Fmax adjust). The bit fields described in the following table can be set to any value between 000(binary) and 111(binary).

Table 13- 5 bias generator trim in dll_ctrl

Field	Setting	Function	Suggested Default
bias_trm[2:0]	000	Fmax trim: minimum adjust	111
	111	Fmax trim: maximum adjust	
bias_trm[6:4]	000	Vc level trim: minimum adjust	011
	111	Vc level trim: maximum adjust	

Feedback Trim:

The feedback trim capability can be used in the event that an adjustment is desired in the phase detector feedback of the DLL. Characteristics of the DLL that may warrant an adjustment of this trim value include non-optimal phase alignment. The lower 3 bits (2:0) are used for feed-back delay trimming and the upper 3 bits (5:3) are used for feed-forward delay trimming. The feed-back trimming is used to decrease total delay, decreasing the amount of delay between phase outputs. The feed-forward trimming is used to increase total delay, increasing the amount of delay between phase outputs. For each 3-bit field, the inputs can be set to any value between 000(binary) and 111(binary).

Table 13- 6MDLL feedback trim in dll_ctrl

Field	Setting	Function	Suggested Default
fb_trm[5:3] (feed-forward path)	000	Minimum additional delay	000
	111	Maximum additional delay	
fb_trm[2:0] (feed-back path)	000	Minimum additional delay	000
	111	Maximum additional delay	

Bypass Mode

The DLL has a bypass mode which allows phased clocks to be generated with analog locking circuitry disabled. This mode may be used for low-speed functional testing and for IDDq testing. Bypass mode can also be used when operating with LPDDR SDRAMs. When bypass mode is enabled, all analog circuitry is disabled, and all static current paths are shut down.

Bypass mode has two settings for the clk_90 delay to optimize it for two different frequency ranges.

Table 13- 7 MDLL bypass mode frequency range in dll_ctrl

Field	Setting	Function	Suggested Default
bps200	0	0 to 100MHz	0
	1	0 to 200MHz	

It is also possible to trim the 90-degree delay using the fdtrm control bits.

Table 13- 8 fdtrm control bits in dll_ctrl

Field	Setting	Function	Suggested Default
fdtrm[1:0]	00	nominal delay	00
	01	nominal delay - 10%	
	10	nominal delay + 10%	
	11	nominal delay + 20%	

13.4.4 Master-Slave DLL(MSDLL)

Master-Slave DLL for DDRII, and LPDDR applications is an integrated Delay Locked Loop and a pair of slave delays. The Delay Locked Loop (DLL) takes an input reference clock (clk_in), and generates four clock outputs, each delayed in quarter clock cycle (90°) increments. These four clock phases (clk_0, clk_90, clk_180, clk_270) can be generated with very high accuracy and low jitter across a wide range of frequencies.

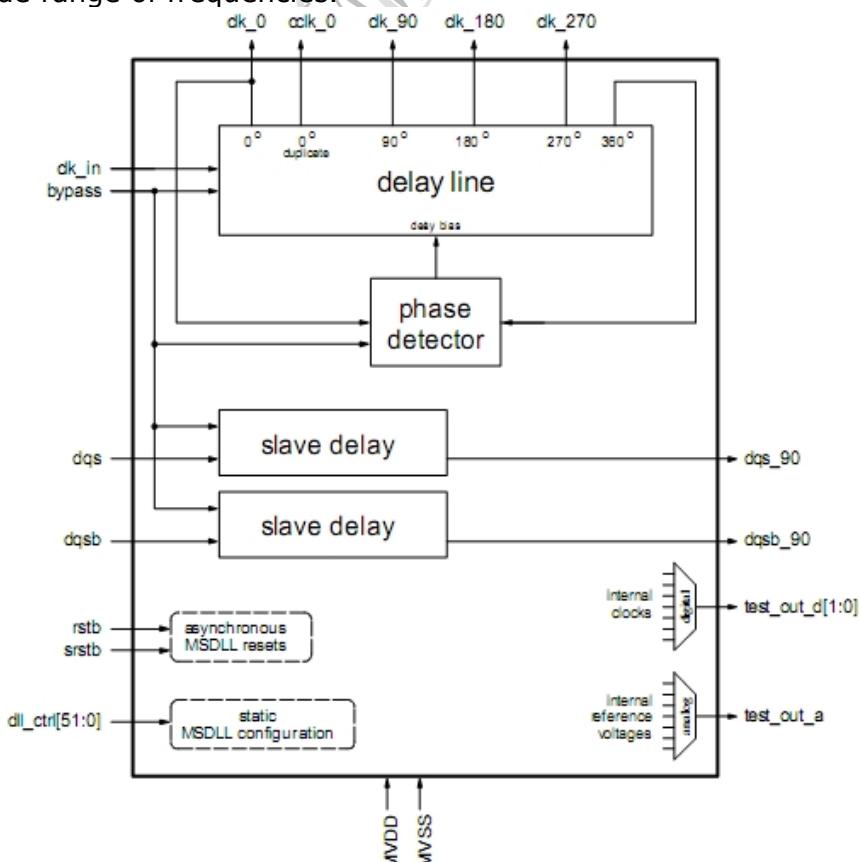


Fig. 13- 6 DDR PHY master-slave DLL architecture diagram

The slave delay pair uses timing reference from the delay line to provide a highly accurate 90° delay to dqs and dqsb inputs (generating dqs_90 and dqsb_90 respectively).

A number of test modes and configuration settings are included:

- ✧ A bypass mode shuts down all analog circuitry, and directly buffers the input clock and strobes with appropriate delays and inversions to the output clocks and strobes. This mode can be used for low speed functional or IDDQ testing.
- ✧ A digital test output (test_out_d) provides direct observability of several internal reference clock and timing nodes.
- ✧ An analog test output (test_out_a) provides direct observability of several internal reference voltages.

The primary application for MSDLL is a DDRII Byte Lane PHY with Interface Timing Modules (ITMs)..

MSDLL Control for Trim and Test

The performance and testing of the MSDLL can be accessed through the dll_ctrl bus. Many of these controls are the same as the MDLL, therefore, this section only describes the settings that are different.

Table 13-9 DDR PHYMSDLL control for trim and test

Static Input	Field	Description
dll_ctrl	[1:0]	Reserved
	[4:2]	ipump_trm[2:0] Charge pump current trim
	[5]	test_ctrl_en Test control enable for analog and digital test outputs
	[8:6]	test_ctrl_d[2:0] Digital test control. Selects the digital signal to be viewed at the digital test output
	[10:9]	test_ctrl_a[1:0] Analog test control. Selects the analog signal to be viewed at the analog test output
	[11]	test_ctrl_switch Test control switch. Selects the analog and digital test signals of master or slave
	[14:12]	bias_trm[2:0] Master bias generator frequency trim
	[19,15]	fdtrm[1:0] Master bypass fixed delay trim
	[18:16]	bias_trm[6:4] Master bias generator control voltage trim
	[22:20]	sl_bias_trm[2:0] Slavebias generator control voltage trim
	[23]	bps200 Bypass frequency select
	[26:24]	sl_bias_trm[6:4] Slave bias generator control voltage trim
	[28:27]	fdtrm_sl[1:0] Slave bypass fixed delay trim
	[29]	lock_det_en Lock detector enable
	[31:30]	Reserved
	[37:32]	sl_fb_trm[5:0] Slave feedback delay adjust
	[43:38]	fb_trm[5:0] Master feedback delay adjust
	[45:44]	sl_bypass_start_up[1:0] Slave auto-startup bypass
	[49:46]	sl_phase_trm[3:0] Slave phase lock trim
	[50]	test_hizb_a Analog test output tri-stated control
	[51]	Reserved

MSDLL Digital Test Control:

Table 13- 10MSDLL digital test control in dll_ctrl

test_ctrl_en	test_ctrl_switch	test_ctrl_d [2:0]	Function	Suggested Default
0	x	xx	digital test outputs disabled (drive '0')	0,0,000
1	0	000	0° output clock (clk_0)	
1		001	90° output clock (clk_90)	
1		010	180° output clock (clk_180)	
1		011	270° output clock (clk_270)	
1		100	360° internal clock (clk_360_int)	
1		101	Master speed-up pulse (spdup)	
1		110	Master slow-down pulse (slwdn)	
1		111	Output clock (cclk_0)	
1		000	Input signal dqs	
1	1	001	Slave input clock reference (clk_90_in)	0,0,000
1		010	Slave internal feedback clock (clk_0_out)	
1		011	Output signal dqsb_90	
1		100	Output signal dqs_90	
1		101	Slave speed-up pulse (spdup)	
1		110	Slave slow-down pulse (slwdn)	
1		111	Auto-lock enable signal	

MSDLL Analog Test Control:

Table 13- 11MSDLL analog test control in dll_ctrl

test_hizb_a	test_ctrl_en	test_ctrl_switch	test_ctrl_a [1:0]	Function	Suggested Default
0	x	x	xx	Tri-state	0,0,0,00
1	0	x	xx	MVSS	
1	1	0	00	Master Filter output (Vc)	
1	1		01	Master Replica bias output for NMOS (Vbn)	
1	1		10	Master Replica bias output for PMOS (Vbp)	
1	1		11	MVDD	
1	1	1	00	Slave Filter output (Vc)	
1	1		01	Slave Replica bias output for NMOS (Vbn)	
1	1		10	Slave Replica bias output for PMOS (Vbp)	
1	1		11	MVDD	

MSDLL Lock Detector Enable:

This setting enables start of the slave DLL section after the master DLL section has reached lock. Characteristics of the DLL that may warrant an adjustment of this trim value include the slave DLL delay remaining in its reset state (minimum delay, much less than 90 degrees) after the DLL lock time.

Table 13- 12MSDLL lock detector enable in dll_ctrl

Field	Setting	Function	Suggested Default
lock_det_en	0	Disable lock detector	0
	1	Enable lock detector	

Slave Auto-Startup Bypass:

By default, the slave DLL automatically starts to lock during the time the master is locking, after the master has begun to approach lock. This setting permits the user to manually start-up the slave DLL. To bypass the automatic startup, this setting should be set to '10'. Once the specified number of clocks has passed for the master DLL to achieve lock, the user sets this field to '11' to permit the slave DLL to startup. The user then waits for the specified number of clocks for the slave DLL to lock before proceeding. Characteristics of the slave DLL that might warrant a manual startup of the slave DLL include the inability for the slave DLL to produce a consistent and/or correct phase difference between the input signal and the output signal.

Table 13- 13 slave auto_startup bypass in dll_ctrl

sl_bypass_start_up[1:0]	Function	Suggested Default
0X	Slave DLL automatically starts up	00
10	Slave DLL's automatic startup is disabled; the phase detector is disabled	
11	Slave DLL's automatic startup is disabled; the phase detector is enabled	

Slave DLL Phase Trim:

Selects the phase difference between the input signal and the corresponding output signal of the slave DLL. This setting applies to the dqs to dqs_90 and dqsb to dqsb_90 paths. The nominal phase difference is 90 degrees. Users may select to modify this value to account for factors external to the DLL, which require the DLL to produce a delay of greater than or less than the nominal 90 degrees. When modifying the value of these bits, the user does not need to issue a reset to the DLL but should wait the equivalent of the DLL lock time before the slave DLL circuitry is used (such as, receiving Read data from an SDRAM) to ensure the DLL has adequate time to stabilize with the new settings.

Table 13- 14 slave DLL phase trim in dll_ctrl

sl_phase_trm[3:0]	Phase Difference (degrees)	Suggested Default
0000	90	0000
0001	72	
0010	54	
0011	36	
0100	108	
0101	90	
0110	72	
0111	54	
1000	126	
1001	108	
1010	90	
1011	72	
1100	144	
1101	126	
1110	108	
1111	90	

MSDLL Bypass Mode

The DLL bypass mode, when enabled, shuts down all analog delay paths and phase detection circuitry and generates output clocks as directly buffered and

inverted versions of clk_in. Bypass mode can be used for low-speed functional testing or for IDDQ testing. Bypass mode can also be used when operating with LPDDR SDRAMs. When bypass mode is enabled, all analog circuitry is disabled, and all static current paths are shut down. Phased outputs are generated during bypass with inverters and standard delays:

clk_0	= buffered clk_in
clk_90	= delayed version of clk_0
clk_180	= inverted clk_0
clk_270	= inverted clk_90
cclk_0	= buffered clk_in
dqs_90	= delayed version of dqs
dqsb_90	= delayed version of dqsb

Bypass mode has two settings for the clk_90 delay to optimize it for two different frequency ranges same as MDLL.

It is also possible to trim the MDLL 90 degree delay using the fdtrm control bits same as MDLL. And it is also possible to trim the MSDLL 90 degree delay using the fdtrm_sl control bits same as fdtrm.

13.4.5 DQS Gating

DDRII systems use a bidirectional data strobe which is driven by the host during memory writes, and by the SDRAM during memory reads. During active read commands, the ITMS basically acts as a buffer for the incoming DQS/DQS_b. A turn-around time exists between operations when neither device is driving the bus, and the strobe traces are held by termination circuitry at a mid-rail voltage.

While the DQS lines are held at mid-rail during inactive periods, an unknown value X is being received by the SSTL inputs. To prevent X from causing false transitions and other negative effects within the read path, the input read dqs strobe path is disabled when there is no active read data. The ITMS provides the functions to enable/disable this path, while the control of these functions is provided by the memory controller logic. A basic view of the enable/disable requirements is shown in following figure.

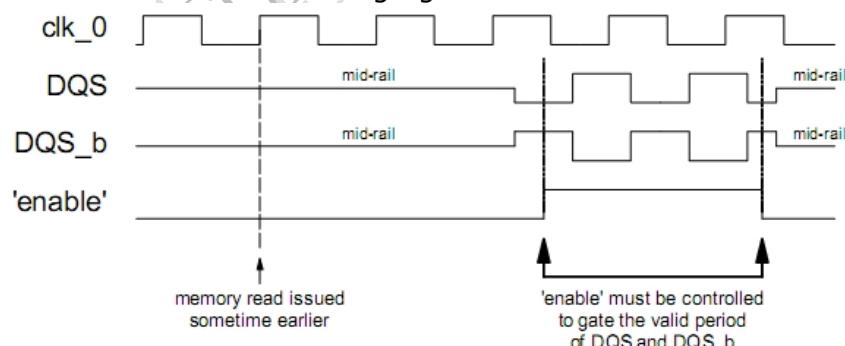


Fig. 13-7 Strobe Gating Requirements During Read Operations

After a read is issued, the SDRAM drives DQS and DQS_b for a number of clock cycles equal to the read burst length. Differing SDRAM CAS latencies, clock cycle times, board trace lengths, and other analog factors between controller and SDRAM result in a variable latency between when the read was issued, and when the returning DQS/DQS_b strobes reach the ITMS. The goal of DQS gating is to control a window, which enables and disables the input read dqs path only when the DQS lines are active, not when they are at mid-rail. There is a pre-amble and post-amble surrounding the active DQS edges that is used as the point to perform the enabling and disabling of this window.

There are two windowing schemes supported by the ITMS - passive windowing and active windowing - which are selected by input dqs_config.

Passive Windowing

In the passive windowing mode (`dqs_config = 1`), the controller asserts `dqs_en` at the start of the window and de-asserts `dqs_en` at the end of the window. This provides the coarse (clock-cycle) position of the enable and disable edges. Fine tuning (1/4 clock cycle) of the window placement is selected by `phase_sel[1:0]`.

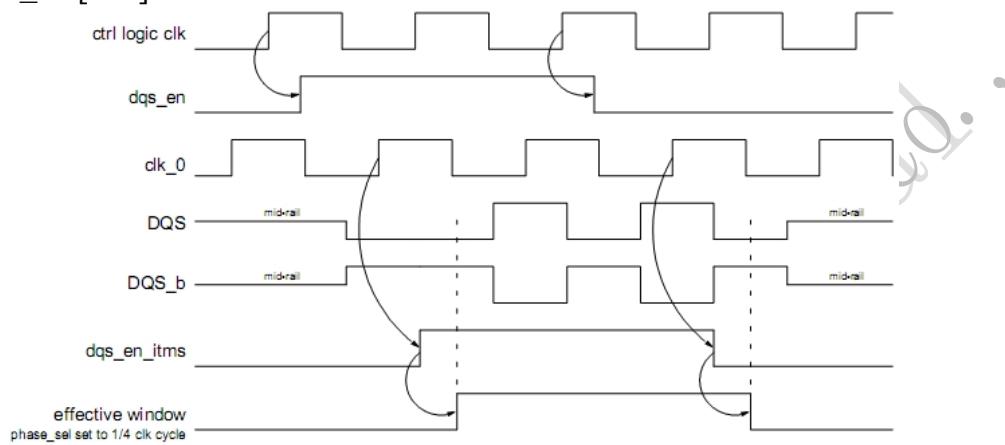


Fig. 13- 8DQS gating – passive windowing mode

The `phase_sel[1:0]` settings are provided.

Table 13- 15 phase selection for dqs gating

phase_sel[1:0] Phase Selection		
Setting	Selected Phase	Offset
00	clk_90 (90 deg)	1/4 clock cycle
01	clk_180 (180 deg)	1/2 clock cycle
10	clk_270 (270 deg)	3/4 clock cycle
11	clk_0 (360 deg)	1 clock cycle

Active Windowing

The active windowing mode addresses the fact that the postamble is shorter than the preamble. The optimal window position for the preamble and postamble are not necessarily the same. In the active windowing mode (`dqs_config = 0`), the controller asserts `dqs_en` for one clock cycle at the start of the window and asserts `dqs_dis` for one clock cycle at the end of the window. Internal to ITMS, the assertion of `dqs_dis` is shifted by a further 180 degrees to account for the fact that `DQS_b` occurs 180 degrees later than `DQS`. This provides the coarse (clock-cycle) position of the enable and disable edges.

Fine tuning (1/4 clock cycle) of the window placement is selected by `phase_sel[1:0]`. The effective window is opened in the same manner as in the passive windowing mode, such as `dqs_en` assertion plus the `phase_sel` offset. To close the window, the controller asserts `dqs_dis` to inform the ITMS to expect the last `DQS_b` rising edge of the burst. The `phase_sel` setting is applied to this to set the effective time at which to expect the last `DQS_b` rising edge. The last `DQS_b` rising edge of the burst is also the last data of the burst. This last `DQS_b` rising edge is used to close the window. Thus, the window is self-closing.

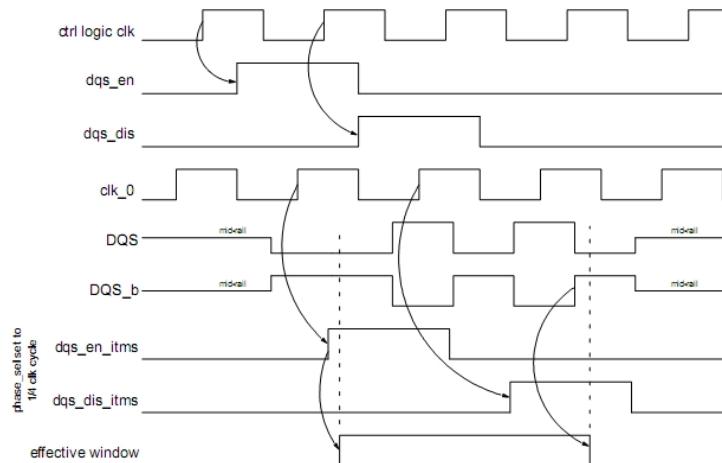


Fig. 13- 9DQS gating – active windowing mode

13.4.6 Dynamic Strobe Drift Detection

DDRII systems can have a long round-trip path from the controller clock output (CK), to the SDRAM, and back to the controller data strobe input (DQS). The sum of potential variations in this path can exceed 25% of a clock cycle at high frequencies (>300MHz), so some compensation should be made if the path delay increases or decreases slowly, but significantly, during normal operation.

The ITMS component has a two-bit strobe drift indicator (dqs_drift), which changes value in grey code if the returning strobe drifts across internal 90° timing reference boundaries. The absolute value of this indicator is not important, but the change in value over time is.

Table 13- 16 dynamic strobe drift indicators

dqs_drift[1:0]		DQS Drift Direction	Required Changes
Old Value	New Value		
00	01	forward	increase read data latency by 90 degrees
	10	backward	decrease read data latency by 90 degrees
01	11	forward	increase read data latency by 90 degrees
	00	backward	decrease read data latency by 90 degrees
10	00	forward	increase read data latency by 90 degrees
	11	backward	decrease read data latency by 90 degrees
11	10	forward	increase read data latency by 90 degrees
	01	backward	decrease read data latency by 90 degrees

13.5 Register description

13.5.1 Registers Summary

Name	Offset	Size	Reset Value	Description
DDR_PCTL_SCFG	0x0000	W	0x00000300	State Configuration Register
DDR_PCTL_SCTL	0x0004	W	0x00000000	Operational State Control Register

Name	Offset	Size	Reset Value	Description
DDR_PCTL_STAT	0x0008	W	0x00000000	Operational State Status Register
DDR_PCTL_INTRSTAT	0x000c	W	0x00000000	Interrupt Status Register
DDR_PCTL_MCMD	0x0040	W	0x00100000	Memory Command Register
DDR_PCTL_POWCTL	0x0044	W	0x00000000	Power Up Control Register
DDR_PCTL_POWSTAT	0x0048	W	0x00000000	Power Up Status Register
DDR_PCTL_CMDTSTAT	0x004c	W	0x00000000	Command Timers Status Register
DDR_PCTL_CMDTSTATEN	0x0050	W	0x00000000	Command Timers Status Enable Register
DDR_PCTL_MRRCFG0	0x0060	W	0x00000000	Mode Register Read Configuration 0
DDR_PCTL_MRRSTAT0	0x0064	W	0x00000000	Mode Register Read Status 0 Register
DDR_PCTL_MRRSTAT1	0x0068	W	0x00000000	Mode Register Read Status 0 Register
DDR_PCTL_MCFG	0x0080	W	0x00040020	Memory Configuration Register
DDR_PCTL_PPFCFG	0x0084	W	0x00000000	Partially Populated Memories Configuration Register
DDR_PCTL_MSTAT	0x0088	W	0x00000000	Memory Status Register
DDR_PCTL_LPDDR2ZQCFG	0x008c	W	0xab0a560a	LPDDR2 ZQ Configuration Register
DDR_PCTL_MCFG1	0x0090	W	0x00000000	Memory Configuration 1 Register

Name	Offset	Size	Reset Value	Description
DDR_PCTL_DTUPDES	0x0094	W	0x00000000 0	DTU Status Register
DDR_PCTL_DTUNA	0x0098	W	0x00000000 0	DTU Number of Addresses Created Register
DDR_PCTL_DTUNE	0x009c	W	0x00000000 0	DTU Number of Errors Register
DDR_PCTL_DTUPRD0	0x00a0	W	0x00000000 0	DTU Parallel Read 0 Register
DDR_PCTL_DTUPRD1	0x00a4	W	0x00000000 0	DTU Parallel Read 1 Register
DDR_PCTL_DTUPRD2	0x00a8	W	0x00000000 0	DTU Parallel Read 2 Register
DDR_PCTL_DTUPRD3	0x00ac	W	0x00000000 0	DTU Parallel Read 3 Register
DDR_PCTL_DTUAWDT	0x00b0	W	0x00000029 0	DTU Address Width Register
DDR_PCTL_TOGCNT1U	0x00c0	W	0x00000006 4	Toggle Counter 1us Register
DDR_PCTL_TINIT	0x00c4	W	0x0000000c 8	t_init Timing Register
DDR_PCTL_TRSTH	0x00c8	W	0x00000000 0	t_rsth Timing Register
DDR_PCTL_TOGCNT100N	0x00cc	W	0x00000000 1	Toggle Counter 100ns
DDR_PCTL_TREFI	0x00d0	W	0x00000000 1	t_refi Timing Register
DDR_PCTL_TMRD	0x00d4	W	0x00000000 1	t_mrd Timing Register
DDR_PCTL_TRFC	0x00d8	W	0x00000000 1	
DDR_PCTL_TRP	0x00dc	W	0x00010000 6	t_trp Timing Register
DDR_PCTL_TRTW	0x00e0	W	0x00000000 2	t_rtw Timing Register
DDR_PCTL_TAL	0x00e4	W	0x00000000 0	AL Register
DDR_PCTL_TCL	0x00e8	W	0x00000000 4	CL Timing Register
DDR_PCTL_TCWL	0x00ec	W	0x00000000 3	CWL Timing Register

Name	Offset	Size	Reset Value	Description
DDR_PCTL_TRAS	0x00f0	W	0x00000010	t_ras Timing Register
DDR_PCTL_TRC	0x00f4	W	0x00000016	t_rc Timing Register
DDR_PCTL_TRCD	0x00f8	W	0x00000006	t_rcd Timing Register
DDR_PCTL_TRRD	0x00fc	W	0x00000004	t_rrd Timing Register
DDR_PCTL_TRTP	0x0100	W	0x00000003	t_rtp Timing Register
DDR_PCTL_TWR	0x0104	W	0x00000006	t_wr Register
DDR_PCTL_TWTR	0x0108	W	0x00000004	t_wtr Timing Register
DDR_PCTL_TEXSR	0x010c	W	0x00000001	t_exsr Timing Register
DDR_PCTL_TXP	0x0110	W	0x00000001	t_xp Timing Register
DDR_PCTL_TXPDLL	0x0114	W	0x00000000	t_xpdll Timing Register
DDR_PCTL_TZQCS	0x0118	W	0x00000000	t_zqcs Timing Register
DDR_PCTL_TZQCSI	0x011c	W	0x00000000	t_zqcsi Timing Register
DDR_PCTL_TDQS	0x0120	W	0x00000001	t_dqs Timing Register
DDR_PCTL_TCKSRE	0x0124	W	0x00000000	t_cksre Timing Register
DDR_PCTL_TCKSRX	0x0128	W	0x00000000	t_cksrx Timing Register
DDR_PCTL_TCKE	0x012c	W	0x00000003	t_cke Timing Register
DDR_PCTL_TMOD	0x0130	W	0x00000000	t_mod Timing Register
DDR_PCTL_TRSTL	0x0134	W	0x00000000	Reset Low Timing Register
DDR_PCTL_TZQCL	0x0138	W	0x00000000	t_zqcl Timing Register
DDR_PCTL_TMRR	0x013c	W	0x00000002	t_mrr Timing Register

Name	Offset	Size	Reset Value	Description
DDR_PCTL_TCkesr	0x0140	W	0x00000000 4	t_ckesr Timing Register
DDR_PCTL_TDPD	0x0144	W	0x00000000 0	t_dpd Timing Register
DDR_PCTL_DtuWactl	0x0200	W	0x00000000 0	DTU Write Address Control
DDR_PCTL_DTURactl	0x0204	W	0x00000000 0	DTU Read Address Control Register
DDR_PCTL_DTUCfg	0x0208	W	0x00000000 0	DTU Configuration Control Register
DDR_PCTL_DTUEctl	0x020c	W	0x00000000 0	DTU Execute Control Register
DDR_PCTL_DtuWd0	0x0210	W	0x00000000 0	DTU Write Data #0 Register
DDR_PCTL_DtuWd1	0x0214	W	0x00000000 0	DTU Write Data #1 Register
DDR_PCTL_DtuWd2	0x0218	W	0x00000000 0	DTU Write Data #2 Register
DDR_PCTL_DtuWd3	0x021c	W	0x00000000 0	DTU Write Data #3 Register
DDR_PCTL_DtuWdm	0x0220	W	0x00000000 0	DTU Write Data Mask Register
DDR_PCTL_DturD0	0x0224	W	0x00000000 0	DTU Read Data #0 Register
DDR_PCTL_DturD1	0x0228	W	0x00000000 0	DTU Read Data #1 Register
DDR_PCTL_DturD2	0x022c	W	0x00000000 0	DTU Read Data #2 Register
DDR_PCTL_DturD3	0x0230	W	0x00000000 0	DTU Read Data #3 Register
DDR_PCTL_DtuLfsrwd	0x0234	W	0x00000000 0	DTU LFSR Seed for Write Data Generation Register
DDR_PCTL_DtuLfsrrd	0x0238	W	0x00000000 0	DTU LFSR Seed for Read Data Generation Register
DDR_PCTL_Dtueaf	0x023c	W	0x00000000 0	DTU Error Address FIFO Register

Name	Offset	Size	Reset Value	Description
DDR_PCTL_DFITCTRLDELAY	0x0240	W	0x00000000 2	DFI tctrl_delay Register
DDR_PCTL_DFIODTCFG	0x0244	W	0x00000000 0	DFI ODT Configuration
DDR_PCTL_DFIODTCFG1	0x0248	W	0x06060000 0	DFI ODT Timing Configuration 1 (for Latency and Length)
DDR_PCTL_DFIODTRANKMAP	0x024c	W	0x00008421	DFI ODT Rank Mapping
DDR_PCTL_DFITPHYWRDATA	0x0250	W	0x00000000 1	DFI tphy_wrdata Register
DDR_PCTL_DFITPHYWRLAT	0x0254	W	0x00000000 1	DFI tphy_wrlat Register
DDR_PCTL_DFITRDDATAEN	0x0260	W	0x00000000 1	DFI trddata_en Register
DDR_PCTL_DFITPHYRDLAT	0x0264	W	0x00000000 f	DFI tphy_rdlat Register
DDR_PCTL_DFITPHYUPDTYPE0	0x0270	W	0x00000010	DFI tphyupd_type0 Register
DDR_PCTL_DFITPHYUPDTYPE1	0x0274	W	0x00000010	DFI tphyupd_type1 Register
DDR_PCTL_DFITPHYUPDTYPE2	0x0278	W	0x00000010	DFI tphyupd_type2 Register
DDR_PCTL_DFITPHYUPDTYPE3	0x027c	W	0x00000010	DFI tphyupd_type3 Register
DDR_PCTL_DFITCTRLUPDMIN	0x0280	W	0x00000010	DFI tctrlupd_min Register
DDR_PCTL_DFITCTRLUPDMAX	0x0284	W	0x00000004 0	DFI tctrlupd_max Register
DDR_PCTL_DFITCTRLUPDDLY	0x0288	W	0x00000000 8	DFI tctrlupddly Register
DDR_PCTL_DFIUPDCFG	0x0290	W	0x00000000 3	DFI Update Configuration Register
DDR_PCTL_DFITREFMSKI	0x0294	W	0x00000000 0	DFI Masked Refresh Interval

Name	Offset	Size	Reset Value	Description
DDR_PCTL_DFITCTRLUPDI	0x0298	W	0x00000000	DFI tctrlupd_interval Register
DDR_PCTL_DFITRCFG0	0x02ac	W	0x00000000	DFI Training Configuration 0 Register
DDR_PCTL_DFITRSTAT0	0x02b0	W	0x00000000	DFI Training Status 0 Register
DDR_PCTL_DFITRWRLVLEN	0x02b4	W	0x00000000	DFI Training dfi_wrlvl_en Register
DDR_PCTL_DFITRRDLVLEN	0x02b8	W	0x00000000	DFI Training dfi_rdlvl_en Register
DDR_PCTL_DFITRRDLVLGATEEN	0x02bc	W	0x00000000	DFI Training dfi_rdlvl_gate_en Register
DDR_PCTL_DFISTSTAT0	0x02c0	W	0x00000000	DFI Status Status 0 Register
DDR_PCTL_DFISTCFG0	0x02c4	W	0x00000000	DFI Status Configuration 0 Register
DDR_PCTL_DFISTCFG1	0x02c8	W	0x00000000	DFI Status Configuration 1 Register
DDR_PCTL_DFITDRAMCLKEN	0x02d0	W	0x00000002	DFI tdram_clk_enable Register
DDR_PCTL_DFITDRAMCLKDIS	0x02d4	W	0x00000002	DFI tdram_clk_disable Register
DDR_PCTL_DFISTCFG2	0x02d8	W	0x00000000	DFI Status Configuration 2 Register
DDR_PCTL_DFISTPARCLR	0x02dc	W	0x00000000	DFI Status Parity Clear Register
DDR_PCTL_DFISTPARLOG	0x02e0	W	0x00000000	DFI Status Parity Log Register
DDR_PCTL_DFLPCFG0	0x02f0	W	0x00070000	DFI Low Power Configuration 0 Register

Name	Offset	Size	Reset Value	Description
DDR_PCTL_DFITRWRLVLRESP0	0x0300	W	0x00000000	DFI Training dfi_wrlvl_resp Status 0 Register
DDR_PCTL_DFITRWRLVLRESP1	0x0304	W	0x00000000	DFI Training dfi_wrlvl_resp Status 1 Register
DDR_PCTL_DFITRWRLVLRESP2	0x0308	W	0x00000000	DFI Training dfi_wrlvl_resp Status 2 Register
DDR_PCTL_DFITRRDLVLRESP0	0x030c	W	0x00000000	DFI Training dfi_rdlvl_resp Status 0 Register
DDR_PCTL_DFITRRDLVLRESP1	0x0310	W	0x00000000	DFI Training dfi_rdlvl_resp Status 1 Register
DDR_PCTL_DFITRRDLVLRESP2	0x0314	W	0x00000000	DFI Training dfi_rdlvl_resp Status 2 Register
DDR_PCTL_DFITRWRLVLDELAY0	0x0318	W	0x00000000	DFI Training dfi_wrlvl_delay Configuration 0 Register
DDR_PCTL_DFITRWRLVLDELAY1	0x031c	W	0x00000000	DFI Training dfi_wrlvl_delay Configuration 1 Register
DDR_PCTL_DFITRWRLVLDELAY2	0x0320	W	0x00000000	DFI Training dfi_wrlvl_delay Configuration 2 Register
DDR_PCTL_DFITRRDLVLDELAY0	0x0324	W	0x00000000	DFI Training dfi_rdlvl_delay Configuration 0 Register
DDR_PCTL_DFITRRDLVLDELAY1	0x0328	W	0x00000000	DFI Training dfi_rdlvl_delay Configuration 1 Register
DDR_PCTL_DFITRRDLVLDELAY2	0x032c	W	0x00000000	DFI Training dfi_rdlvl_delay Configuration 2 Register

Name	Offset	Size	Reset Value	Description
DDR_PCTL_DFITRRDLVLGATE_DELAY0	0x0330	W	0x00000000	DFI Training dfi_rdlvl_gate_delay Configuration 0
DDR_PCTL_DFITRRDLVLGATE_DELAY1	0x0334	W	0x00000000	DFI Training dfi_rdlvl_gate_delay Configuration 1
DDR_PCTL_DFITRRDLVLGATE_DELAY2	0x0338	W	0x00000000	DFI Training dfi_rdlvl_gate_delay Configuration 2
DDR_PCTL_DFITRCMD	0x033c	W	0x00000000	DFI Training Command Register
DDR_PCTL_IPVR	0x03f8	W	0x00000000	IP Version Register
DDR_PCTL_IPTR	0x03fc	W	0x44574300	IP Type Register

Name	Offset	Size	Reset Value	Description
DDR_PHYCTL_RIDR	0x0000	W	0x00100140	Revision Identification Register
DDR_PHYCTL_PIR	0x0004	W	0x00000000	PHY Initialization Register
DDR_PHYCTL_PGCR	0x0008	W	0x01bc2e04	PHY General Configuration Register
DDR_PHYCTL_PGSR	0x000c	W	0x00000000	PHY General Status Register
DDR_PHYCTL_DLLGCR	0x0010	W	0x03737000	DLL General Control Register
DDR_PHYCTL_ACDLLCR	0x0014	W	0x40000000	AC DLL Control Register
DDR_PHYCTL_PTR0	0x0018	W	0x0022af9b	PHY Timing Register 0
DDR_PHYCTL_PTR1	0x001c	W	0x0604111d	PHY Timing Register 1
DDR_PHYCTL_PTR2	0x0020	W	0x042da072	PHY Timing Register 2
DDR_PHYCTL_ACIOCR	0x0024	W	0x33c03812	AC I/O Configuration Register
DDR_PHYCTL_DXCCR	0x0028	W	0x00000800	DATX8 Common Configuration Register
DDR_PHYCTL_DSGCR	0x002c	W	0xfa00001f	DDR System General Configuration Register
DDR_PHYCTL_DCR	0x0030	W	0x0000000b	DRAM Configuration Register

Name	Offset	Size	Reset Value	Description
DDR_PHYCTL_DTPR0	0x0034	W	0x3092666e	DRAM Timing Parameters Register 0
DDR_PHYCTL_DTPR1	0x0038	W	0x09830090	DRAM Timing Parameters Register 1
DDR_PHYCTL_DTPR2	0x003c	W	0x1001a0c8	DRAM Timing Parameters Register 2
DDR_PHYCTL_MR0	0x0040	W	0x00000a52	Mode Register 0
DDR_PHYCTL_MR1	0x0044	W	0x00000000	Mode Register 1
DDR_PHYCTL_MR2	0x0048	W	0x00000000	Mode Register 2
DDR_PHYCTL_MR3	0x004c	W	0x00000000	Mode Register 3
DDR_PHYCTL_ODTCR	0x0050	W	0x00210000	ODT Configuration Register
DDR_PHYCTL_DTAR	0x0054	W	0x00000000	Data Training Address Register
DDR_PHYCTL_DTDR0	0x0058	W	0xdd22ee11	Data Training Data Register 0
DDR_PHYCTL_DTDR1	0x005c	W	0x7788bb44	Data Training Data Register 1
DDR_PHYCTL_DCUAR	0x00c0	W	0x00000000	DCU Address Register
DDR_PHYCTL_DCUDR	0x00c4	W	0x00000000	DCU Data Register
DDR_PHYCTL_DCURR	0x00c8	W	0x00000000	DCU Run Register
DDR_PHYCTL_DCULR	0x00cc	W	0x00000000	DCU Loop Register
DDR_PHYCTL_DCUGCR	0x00d0	W	0x00000000	DCU General Configuration Register
DDR_PHYCTL_DCUTPR	0x00d4	W	0x00000000	DCU Timing Parameters Registers
DDR_PHYCTL_DCUSR0	0x00d8	W	0x00000000	DCU Status Register 0
DDR_PHYCTL_DCUSR1	0x00dc	W	0x00000000	DCU Status Register 1
DDR_PHYCTL_BISTRR	0x0100	W	0x00000000	BIST Run Register
DDR_PHYCTL_BISTMSKR0	0x0104	W	0x00000000	BIST Mask Register 0
DDR_PHYCTL_BISTMSKR1	0x0108	W	0x00000000	BIST Mask Register 1
DDR_PHYCTL_BISTWCR	0x010c	W	0x00000020	BIST Word Count Register
DDR_PHYCTL_BISTLSR	0x0110	W	0x1234abcd	BIST LFSR Seed Register
DDR_PHYCTL_BISTAR0	0x0114	W	0x00000000	BIST Address Register 0
DDR_PHYCTL_BISTAR1	0x0118	W	0x0000000c	BIST Address Register 1
DDR_PHYCTL_BISTAR2	0x011c	W	0x7fffffff	BIST Address Register 2
DDR_PHYCTL_BISTUDPR	0x0120	W	0xfffff0000	BIST User Data Pattern Register
DDR_PHYCTL_BISTGSR	0x0124	W	0x00000000	BIST General Status Register

Name	Offset	Size	Reset Value	Description
DDR_PHYCTL_BISTWER	0x0128	W	0x00000000	BIST Word Error Register
DDR_PHYCTL_BISTBER0	0x012c	W	0x00000000	BIST Bit Error Register 0
DDR_PHYCTL_BISTBER1	0x0130	W	0x00000000	BIST Bit Error Register 1
DDR_PHYCTL_BISTBER2	0x0134	W	0x00000000	BIST Bit Error Register 2
DDR_PHYCTL_BISTWCSR	0x0138	W	0x00000000	BIST Word Count Status Register
DDR_PHYCTL_BISTFWR0	0x013c	W	0x00000000	BIST Fail Word Register 0
DDR_PHYCTL_BISTFWR1	0x0140	W	0x00000000	BIST Fail Word Register 1
DDR_PHYCTL_ZQ0CR0	0x0180	W	0x0000014a	ZQ 0 Impedance Control Register 0
DDR_PHYCTL_ZQ0CR1	0x0184	W	0x0000007b	ZQ 0 Impedance Control Register 1
DDR_PHYCTL_ZQ0SR0	0x0188	W	0x00000000	ZQ 0 Impedance Status Register 0
DDR_PHYCTL_ZQ0SR1	0x018c	W	0x00000000	ZQ 0 Impedance Status Register 1
DDR_PHYCTL_ZQ1CR0	0x0190	W	0x0000014a	ZQ 1 Impedance Control Register 0
DDR_PHYCTL_ZQ1CR1	0x0194	W	0x0000007b	ZQ 1 Impedance Control Register 1
DDR_PHYCTL_ZQ1SR0	0x0198	W	0x00000000	ZQ 1 Impedance Status Register 0
DDR_PHYCTL_ZQ1SR1	0x019c	W	0x00000000	ZQ 1 Impedance Status Register 1
DDR_PHYCTL_ZQ2CR0	0x01a0	W	0x0000014a	ZQ 2 Impedance Control Register 0
DDR_PHYCTL_ZQ2CR1	0x01a4	W	0x0000007b	ZQ 2 Impedance Control Register 1
DDR_PHYCTL_ZQ2SR0	0x01a8	W	0x00000000	ZQ 2 Impedance Status Register 0
DDR_PHYCTL_ZQ2SR1	0x01ac	W	0x00000000	ZQ 2 Impedance Status Register 1
DDR_PHYCTL_ZQ3CR0	0x01b0	W	0x0000014a	ZQ 3 Impedance Control Register 0
DDR_PHYCTL_ZQ3CR1	0x01b4	W	0x0000007b	ZQ 3 Impedance Control Register 1
DDR_PHYCTL_ZQ3SR0	0x01b8	W	0x00000000	ZQ 3 Impedance Status Register 0

Name	Offset	Size	Reset Value	Description
DDR_PHYCTL_ZQ3SR1	0x01bc	W	0x00000000	ZQ 3 Impedance Status Register 1
DDR_PHYCTL_DX0GCR	0x01c0	W	0x00000681	DATX8 0 General Configuration Register
DDR_PHYCTL_DX0GSR0	0x01c4	W	0x00000000	DATX8 0 General Status Register 0
DDR_PHYCTL_DX0GSR1	0x01c8	W	0x00000000	DATX8 0 General Status Register 1
DDR_PHYCTL_DX0DLLCR	0x01cc	W	0x40000000	DATX8 0 DLL Control Register
DDR_PHYCTL_DX0DQTR	0x01d0	W	0xffffffff	DATX8 0 DQ Timing Register
DDR_PHYCTL_DX0DQSTR	0x01d4	W	0x3db55000	DATX8 0 DQS Timing Register
DDR_PHYCTL_DX1GCR	0x0200	W	0x00000681	DATX8 1 General Configuration Register
DDR_PHYCTL_DX1GSR0	0x0204	W	0x00000000	DATX8 1 General Status Register 0
DDR_PHYCTL_DX1GSR1	0x0208	W	0x00000000	DATX8 1 General Status Register 1
DDR_PHYCTL_DX1DLLCR	0x020c	W	0x40000000	DATX8 1 DLL Control Register
DDR_PHYCTL_DX1DQTR	0x0210	W	0xffffffff	DATX8 1 DQ Timing Register
DDR_PHYCTL_DX1DQSTR	0x0214	W	0x3db55000	DATX8 1 DQS Timing Register
DDR_PHYCTL_DX2GCR	0x0240	W	0x00000681	DATX8 2 General Configuration Register
DDR_PHYCTL_DX2GSR0	0x0244	W	0x00000000	DATX8 2 General Status Register 0
DDR_PHYCTL_DX2GSR1	0x0248	W	0x00000000	DATX8 2 General Status Register 1
DDR_PHYCTL_DX2DLLCR	0x024c	W	0x40000000	DATX8 2 DLL Control Register
DDR_PHYCTL_DX2DQTR	0x0250	W	0xffffffff	DATX8 2 DQ Timing Register
DDR_PHYCTL_DX2DQSTR	0x0254	W	0x3db55000	DATX8 2 DQS Timing Register
DDR_PHYCTL_DX3GCR	0x0280	W	0x00000681	DATX8 3 General Configuration Register

Name	Offset	Size	Reset Value	Description
DDR_PHYCTL_DX3GSR0	0x0284	W	0x00000000	DATX8 3 General Status Register 0
DDR_PHYCTL_DX3GSR1	0x0288	W	0x00000000	DATX8 3 General Status Register 1
DDR_PHYCTL_DX3DLLCR	0x028c	W	0x40000000	DATX8 3 DLL Control Register
DDR_PHYCTL_DX3DQTR	0x0290	W	0xffffffff	DATX8 3 DQ Timing Register
DDR_PHYCTL_DX3DQSTR	0x0294	W	0x3db55000	DATX8 3 DQS Timing Register

13.5.2 Detail Registers Description

DDR_PCTL_SCFG

Address: Operational Base + offset (0x0000)
State Configuration Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:8	RW	0x3	<p>bbflags_timing</p> <p>The n_bbflags is a NIF output vector which provides combined information about the status of each memory bank. The de-assertion is based on when precharge, activates, reads/writes are scheduled by the TCU block. It may be possible to de-assert n_bbflags earlier than calculated by the TCU block. Programming bbflags_timing is used to achieve this. The maximum recommended value is: PCTL_TCU_SED_P - TRP.t_rp. The programmed value is the maximum number of "early" cycles that n_bbflags maybe de-asserted. The actual achieved de-assertion depends on the traffic profile.</p> <p>In 1:2 mode the maximum allowed programmable value is 4'b0111</p> <p>In 1:1 mode the value can be 4'b1111</p>
7:1	RO	0x0	reserved

Bit	Attr	Reset Value	Description
0	RW	0x0	<p>hw_low_power_en Enables the hardware low-power interface. Allows the system to request via hardware (c_sysreq input) to enter the memories into Self-Refresh.</p> <p>The handshaking between the request and acknowledge hardware low power signals (c_sysreq and c_sysack, respectively) is always performed, but the PCTL response depends on the value set on this register field and by the value driven on the c_active_in input pin.</p> <p>1'b0 = Disabled. Requests are always denied and PCTL is unaffected by c_sysreq 1'b1 = Enabled. Requests are accepted or denied, depending on the current operational state of PCTL and on the value of c_active_in.</p>

DDR_PCTL_SCTL

Address: Operational Base + offset (0x0004)

Operational State Control Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2:0	RW	0x0	<p>state_cmd Issues an operational state transition request to the PCTL. 3'b000 = INIT (move to Init_mem from Config) 3'b001 = CFG (move to Config from Init_mem or Access) 3'b010 = GO (move to Access from Config) 3'b011 = SLEEP (move to Low_power from Access) 3'b100 = WAKEUP (move to Access from Low_power) Others = Reserved</p>

DDR_PCTL_STAT

Address: Operational Base + offset (0x0008)

Operational State Status Register

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved

Bit	Attr	Reset Value	Description
6:4	RO	0x0	<p>lp_trig</p> <p>Reports the status of what triggered an entry to Low_power state. Is only set if in Low_power state. The individual bits report the following:</p> <ul style="list-style-type: none"> - lp_trig[2]: Software driven due to SCTL.state_cmd==SLEEP. - lp_trig[1]: Hardware driven due to Hardware Low Power Interface. - lp_trig[0]: Hardware driven due to Auto Self Refresh (MCFG1.sr_idle>0). <p>Note, if more than one trigger happens at the exact same time, more than one bit of lp_trig may be asserted high.</p>
3	RO	0x0	reserved
2:0	RO	0x0	<p>ctl_stat</p> <p>Returns the current operational state of the PCTL.</p> <p>3'b000 = Init_mem 3'b001 = Config 3'b010 = Config_req 3'b011 = Access 3'b100 = Access_req 3'b101 = Low_power 3'b110 = Low_power_entry_req 3'b111 = Low_power_exit_req Others = Reserved</p>

DDR_PCTL_INTRSTAT

Address: Operational Base + offset (0x000c)

Interrupt Status Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RO	0x0	<p>parity_intr</p> <p>Indicates that a DFI parity error has been detected</p> <p>1'b0 = No error 1'b1 = Parity error</p>
0	RO	0x0	<p>ecc_intr</p> <p>Indicates that an ECC error has been detected</p> <p>1'b0 = No error 1'b1 = Parity error</p>

DDR_PCTL_MCMD

Address: Operational Base + offset (0x0040)

Memory Command Register

Bit	Attr	Reset Value	Description
31	RWSC	0x0	start_cmd Start command. When this bit is set to 1, the command operation defined in the cmd_opcode field is started. This bit is automatically cleared by the PCTL after the command is finished. The application can poll this bit to determine when PCTL is ready to accept another command. This bit cannot be cleared to 1'b0 by software.
30:28	RO	0x0	reserved
27:24	RW	0x0	cmd_add_del Set the additional delay associated with each command to 2^n internal timers clock cycles, where n is the bit field value. If n=0, the delay is 0. Max value is n=10.
23:20	RW	0x1	rank_sel Rank select for the command to be executed. 4'b0001 = Rank 0 4'b0010 = Rank 1 4'b0100 = Rank 2 4'b1000 = Rank 3 4'b0000 = Reserved Multiple 1'b1s in rank_sel mean multiple ranks are selected, which is useful broadcasting commands in parallel to multiple ranks during initialization and configuration of the memories. If MCMD.cmd_opcode=RSTL, all ranks should be selected as it cannot be performed to individual ranks

Bit	Attr	Reset Value	Description
19:17	RW	0x0	<p>bank_addr</p> <p>Mode Register address driven on the memory bank address bits, BA1, BA0, during a Mode Register Set operation, defined by cmd_opcode=MRS. For other values of cmd_opcode, this field is ignored.</p> <p>3'b000 = MR0 (MR in DDR2)</p> <p>3'b001 = MR1 (EMR in DDR2)</p> <p>3'b010 = MR2 (EMR(2) in DDR2)</p> <p>3'b011 = MR3 (EMR(3) in DDR2)</p> <p>Others = Reserved</p>
16:4	RW	0x0000	<p>cmd_addr</p> <p>Mode Register value driven on the memory address bits, A12 to A0, during a Mode Register Set operation defined by cmd_opcode=MRS. For other values of cmd_opcode this field is ignored. Refer to the memory specification for the correct settings of the various bits of this field during a MRS operation.</p> <p>If LPDDR2, this fields is merged into bank_addr - lpddr2_addr</p>

Bit	Attr	Reset Value	Description
3:0	RW	0x0	<p>cmd_opcode Command to be issued to the memory.</p> <p>4'b000 = Deselect. This is only used for timing purposes, no actual direct Deselect command is passed to the memories.</p> <p>4'b0001 = Precharge All (PREA)</p> <p>4'b0010 = Refresh (REF)</p> <p>4'b0011 = Mode Register Set (MRS) - is MRW in LPDDR2, MRS otherwise</p> <p>4'b0100 = ZQ Calibration Short (ZQCS, only applies to LPDDR2/DDR3)</p> <p>4'b0101 = ZQ Calibration Long (ZQCL, only applies to LPDDR2/DDR3)</p> <p>4'b0110 = Software Driven Reset (RSTL, only applies to DDR3)</p> <p>4'b0111 = Reserved</p> <p>4'b1000 - Mode Register Read (MRR) - is MRR in LPDDR2, is SRR in mDRR and is MPR in DDR3</p> <p>4'b1001 - Deep Power Down Entry (DPDE, only applies to mDDR/LPDDR2)</p> <p>Others - Reserved</p>

DDR_PCTL_POWCTL

Address: Operational Base + offset (0x0044)

Power Up Control Register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RWSC	0x0	<p>power_up_start Start the memory power up sequence.</p> <p>When this bit is set to 1'b1, PCTL starts the CKE and RESET# power up sequence to the memories. This bit is automatically cleared by PCTL after the sequence is completed. This bit cannot be cleared to 1'b0 by software.</p>

DDR_PCTL_POWSTAT

Address: Operational Base + offset (0x0048)

Power Up Status Register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved

Bit	Attr	Reset Value	Description
0	RO	0x0	<p>power_up_done</p> <p>Returns the status of the memory power-up sequence.</p> <p>1'b0 = Power-up sequence has not been performed.</p> <p>1'b1 = Power-up sequence has been performed.</p>

DDR_PCTL_CMDTSTAT

Address: Operational Base + offset (0x004c)

Command Timers Status Register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RO	0x0	<p>cmd_tstat</p> <p>Returns the status of the timers for memory commands.</p> <p>This ANDs all the command timers together.</p> <p>1'b0 = One or more command timers has not expired.</p> <p>1'b1 = All command timers have expired.</p>

DDR_PCTL_CMDTSTATEN

Address: Operational Base + offset (0x0050)

Command Timers Status Enable Register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	<p>cmd_tstat_en</p> <p>Enables the generation of the status of the timers for memory commands.</p> <p>Is enabled before CMDTSTAT register is read.</p> <p>1'b0 - Disabled</p> <p>1'b1 - Enabled</p>

DDR_PCTL_MRRCFG0

Address: Operational Base + offset (0x0060)

Mode Register Read Configuration 0

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x0	<p>mrr_byte_sel</p> <p>Selects which byte's data to store when performing an MRR command via MCMD.</p> <p>LegalValues: 0 .. 8</p>

DDR_PCTL_MRRSTAT0

Address: Operational Base + offset (0x0064)

Mode Register Read Status 0 Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	mrrstat_beat3 MRR/MPR read data beat 3
23:16	RO	0x00	mrrstat_beat2 MRR/MPR read data beat 2
15:8	RO	0x00	mrrstat_beat1 MRR/MPR read data beat 1
7:0	RO	0x00	mrrstat_beat0 MRR/MPR read data beat 0

DDR_PCTL_MRRSTAT1

Address: Operational Base + offset (0x0068)

Mode Register Read Status 0 Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	mrrstat_beat7 MRR/MPR read data beat 7
23:16	RO	0x00	mrrstat_beat6 MRR/MPR read data beat 6
15:8	RO	0x00	mrrstat_beat5 MRR/MPR read data beat 5
7:0	RO	0x00	mrrstat_beat4 MRR/MPR read data beat 4

DDR_PCTL_MCFG

Address: Operational Base + offset (0x0080)

Memory Configuration Register

Bit	Attr	Reset Value	Description
31:24	RW	0x00	mddr_lpddr2_clock_stop_idle Clock stop idle period in n_clk cycles. Memories are placed into clock stop mode if the NIF is idle for mddr_lpddr2_clkstop_idle n_clk cycles. The automatic clock stop function is disabled when mddr_lpddr2_clkstop_idle=0. Clock stop mode is only applicable in mDDR/LPDDR2.

Bit	Attr	Reset Value	Description
23:22	RW	0x0	<p>mddr_lpddr2_en mDDR/LPDDR2 Enable. Enables support for mDDR or LPDDR2. 2'b00 = mDDR/LPDDR2 Disabled 2'b10 = mDDR Enabled 2'b11 = LPDDR2 Enabled Others= Reserved.</p>
21:20	RW	0x0	<p>mddr_lpddr2_bl mDDR/LPDDR2 Burst Length. The BL setting must be consistent with the value programmed into the BL field of MR. 2'b00 = BL2, Burst length of 2 (MR.BL=3'b001, mDDR only) 2'b01 = BL4, Burst length of 4 (MR.BL=3'b010, for mDDR and LPDDR2) 2'b10 = BL8, Burst length of 8 (MR.BL=3'b011, for mDDR and LPDDR2) 2'b11 = BL16, Burst length of 16 (MR.BL=3'b100, for mDDR and LPDDR2) This value is effective only if MCFG.mddr_lpddr2_en[1]=1'b1. Otherwise, MCFG.mem_bl is used to define PCTL's Burst Length (for DDR2/DDR3).</p>
19:18	RW	0x1	<p>tfaw_cfg Sets tFAW to be 4, 5 or 6 times tRRD. 2'b00 = set tFAW=4*tRRD 2'b01 = set tFAW=5*tRRD 2'b10 = set tFAW=6*tRRD</p>
17	RW	0x0	<p>pd_exit_mode Selects the mode for Power Down Exit. For DDR2/DDR3, the power down exit mode setting in PCTL must be consistent with the value programmed into the power down exit mode bit of MRO. For mDDR/LPDDR2, only fast exit mode is valid. 1'b0 = slow exit 1'b1 = fast exit</p>
16	RW	0x0	<p>pd_type Sets the Power down type. 1'b0 = Precharge Power Down 1'b1 = Active Power Down</p>

Bit	Attr	Reset Value	Description
15:8	RW	0x00	<p>pd_idle Power-down idle period in n_clk cycles. Memories are placed into power-down mode if the NIF is idle for pd_idle n_clk cycles. The automatic power down function is disabled when pd_idle=0.</p>
7	RO	0x0	reserved
6	RW	0x0	<p>lpddr2_s4 Enables LPDDR2-S4 support. 1'b0 = LPDDR2-S4 disabled (LPDDR2-S2 enabled) 1'b1 = LPDDR2-S4 enabled</p>
5	RW	0x1	<p>ddr3_en Select DDR2 or DDR3 protocol. Ignored, if mDDR or LPDDR2 support is enabled. 1'b0 = DDR2 Protocol Rules 1'b1 = DDR3 Protocol Rules</p>
4	RW	0x0	<p>stagger_cs For multi-rank commands from the DCU, stagger the assertion of CS_N to odd and even ranks by one n_clk cycle. This is useful when using RDIMMs, when multi-rank commands may be interpreted as writes to control words in the register chip. 1'b0 = Do not stagger CS_N 1'b1 = Stagger CS_N</p>
3	RW	0x0	<p>two_t_en Enables 2T timing for memory commands. 1'b0= Disabled 1'b1 = Enabled</p>
2	RW	0x0	<p>bl8int_en Setting this bit enables the BL8 interrupt function of DDR2. This is the capability to early terminate a BL8 after only 4 DDR beats by issuing the next command two cycles earlier. This functionality is only available for DDR2 memories and this setting is ignored for mDDR/LPDDR2 and DDR3. 1'b0 = Disabled 1'b1 = Enabled</p>

Bit	Attr	Reset Value	Description
1	RW	0x0	<p>cke_or_en</p> <p>This bit is intended to be set for 4-rank RDIMMs, which have a 2-bit CKE input. If set, dfi_cke[0] is asserted to enable either of the even ranks (0 and 2), while dfi_cke[1] is asserted to enable either of the odd ranks (1 and 3). dfi_cke[3:2] are inactive (0)</p> <p>1'b0: Disabled 1'b1: Enabled</p>
0	RW	0x0	<p>mem_bl</p> <p>DDR Burst Length. The BL setting in DDR2 / DDR3 must be consistent with the value programmed into the BL field of MR0.</p> <p>1'b0 = BL4, Burst length of 4 (MR0.BL=3'b010, DDR2 only) 1'b1 = BL8, Burst length of 8 (MR0.BL=3'b011 for DDR2, MR0.BL=2'b00 for DDR3)</p>

DDR_PCTL_PPcfg

Address: Operational Base + offset (0x0084)

Partially Populated Memories Configuration Register

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8:1	RW	0x00	<p>rpmem_dis</p> <p>Reduced Population Disable bits. Setting these bits disables the corresponding NIF/DDR data lanes from writing or reading data. Lane 0 is always present, hence only 8 bits are required for the remaining lanes including the ECC lane.</p> <p>In 1:2 mode bit 0 of rpmem_dis covers n_wdata/n_rdata/m_ctl_d/m_phy_q[63:32], bit 1 [95:64] etc.</p> <p>In 1:1 mode bit 0 of rpmem_dis covers n_wdata/n_rdata/m_ctl_d/m_phy_q[31:16], bit 2 [47:32] etc.</p> <p>There are no restrictions on which byte lanes can be disabled, other than byte lane 0 is required.</p> <p>Gaps between enabled byte lanes are allowed</p> <p>For each bit:</p> <p>1'b0 = lane exists 1'b1 = lane is disabled</p>

Bit	Attr	Reset Value	Description
0	RW	0x0	<p>ppmem_en</p> <p>Partially Population Enable bit. Setting this bit enables the partial population of external memories where the entire application bus is routed to a reduced size memory system. The lower half of the SDRAM data bus, bit 0 up to bit PCTL_M_DW/2-1, is the active portion when Partially Populated memories are enabled.</p> <p>1'b0 = Disabled 1'b1 = Enabled</p>

DDR_PCTL_MSTAT

Address: Operational Base + offset (0x0088)

Memory Status Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2	RO	0x0	<p>self_refresh</p> <p>Indicates if PCTL, through auto self refresh, has placed the memories in Self Refresh.</p> <p>1'b0 = Memory is not in Self Refresh 1'b1 = Memory is in Self Refresh</p>
1	RO	0x0	<p>clock_stop</p> <p>Indicates if PCTL has placed the memories in Clock Stop.</p> <p>1'b0 = Memory is not in Clock Stop 1'b1 = Memory is in Clock Stop</p>
0	RO	0x0	<p>power_down</p> <p>Indicates if PCTL has placed the memories in Power Down.</p> <p>1'b0 = Memory is not in Power Down 1'b1 = Memory is in Power-Down</p>

DDR_PCTL_LPDDR2ZQCFG

Address: Operational Base + offset (0x008c)

LPDDR2 ZQ Configuration Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:24	RW	0xab	zqcl_op Value to drive on memory address bits [19:12] for an automatic hardware generated ZQCL command (LPDDR2). Corresponds to OP7 .. OP0 of Mode Register Write (MRW) command which is used to send ZQCL command to memory.
23:16	RW	0x0a	zqcl_ma Value to drive on memory address bits [11:4] for an automatic hardware generated ZQCL command (LPDDR2). Corresponds to MA7 .. MA0 of Mode Register Write (MRW) command which is used to send ZQCL command to memory.
15:8	RW	0x56	zqcs_op Value to drive on memory address bits [19:12] for an automatic hardware generated ZQCS command (LPDDR2). Corresponds to OP7 .. OP0 of Mode Register Write (MRW) command which is used to send ZQCS command to memory.
7:0	RW	0x0a	zqcs_ma Value to drive on memory address bits [11:4] for an automatic hardware generated ZQCS command (LPDDR2). Corresponds to MA7 .. MA0 of Mode Register Write (MRW) command which is used to send ZQCS command to memory.

DDR_PCTL_MCFG1

Address: Operational Base + offset (0x0090)

Memory Configuration 1 Register

Bit	Attr	Reset Value	Description
31	RW	0x0	hw_exit_idle_en When this bit is programmed to 1'b1 the c_active_in pin can be used to exit from the automatic clock stop , power down or self-refresh modes.
30:24	RO	0x0	reserved

Bit	Attr	Reset Value	Description
23:16	RW	0x00	hw_idle Hardware idle period. The c_active output is driven high if the NIF is idle in Access state for hw_idle * 32 * n_clk cycles. The hardware idle function is disabled when hw_idle=0.
15:8	RO	0x0	reserved
7:0	RW	0x00	sr_idle Self Refresh idle period. Memories are placed into Self-Refresh mode if the NIF is idle in Access state for sr_idle * 32 * n_clk cycles. The automatic self refresh function is disabled when sr_idle=0.

DDR_PCTL_DTUPDES

Address: Operational Base + offset (0x0094)

DTU Status Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RO	0x0	dtu_rd_missing Indicates if one or more read beats of data did not return from memory.
12:9	RO	0x0	dtu_eaffl Indicates the number of entries in the FIFO that is holding the log of error addresses for data comparison
8	RO	0x0	dtu_random_error Indicates that the random data generated had some failures when written and read to the memories
7	RO	0x0	dtu_err_b7 Detected at least 1 bit error for bit 7 in the programmable data buffers
6	RO	0x0	dtu_err_b6 Detected at least 1 bit error for bit 6 in the programmable data buffers
5	RO	0x0	dtu_err_b5 Detected at least 1 bit error for bit 5 in the programmable data buffers
4	RO	0x0	dtu_err_b4 Detected at least 1 bit error for bit 4 in the programmable data buffers

Bit	Attr	Reset Value	Description
3	RO	0x0	dtu_err_b3 Detected at least 1 bit error for bit 3 in the programmable data buffers
2	RO	0x0	dtu_err_b2 Detected at least 1 bit error for bit 2 in the programmable data buffers
1	RO	0x0	dtu_err_b1 Detected at least 1 bit error for bit 1 in the programmable data buffers
0	RO	0x0	dtu_err_b0 Detected at least 1 bit error for bit 0 in the programmable data buffers

DDR_PCTL_DTUNA

Address: Operational Base + offset (0x0098)

DTU Number of Addresses Created Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	dtu_num_address Indicates the number of addresses that were created on the NIF interface during random data generation.

DDR_PCTL_DTUNE

Address: Operational Base + offset (0x009c)

DTU Number of Errors Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	dtu_num_errors Indicates the number of errors that were detected on the readback of the NIF data during random data generation.

DDR_PCTL_DTUPRDO

Address: Operational Base + offset (0x00a0)

DTU Parallel Read 0 Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	dtu_allbits_1 Allows all the bit ones from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.

Bit	Attr	Reset Value	Description
15:0	RO	0x0000	dtu_allbits_0 Allows all the bit zeros from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.

DDR_PCTL_DTUPRD1

Address: Operational Base + offset (0x00a4)

DTU Parallel Read 1 Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	dtu_allbits_3 Allows all the bit threes from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.
15:0	RO	0x0000	dtu_allbits_2 Allows all the bit twos from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.

DDR_PCTL_DTUPRD2

Address: Operational Base + offset (0x00a8)

DTU Parallel Read 2 Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	dtu_allbits_5 Allows all the bit fives from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.
15:0	RO	0x0000	dtu_allbits_4 Allows all the bit fours from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.

DDR_PCTL_DTUPRD3

Address: Operational Base + offset (0x00ac)

DTU Parallel Read 3 Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	dtu_allbits_7 Allows all the bit sevens from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.
15:0	RO	0x0000	dtu_allbits_6 Allows all the bit sixes from each of the 16 received read bytes to be read in parallel. Used as part of read data eye training where a transition is required to be monitored to train the eye.

DDR_PCTL_DTUAWDT

Address: Operational Base + offset (0x00b0)

DTU Address Width Register

Bit	Attr	Reset Value	Description
31:11	RO	0x0	reserved
10:9	RW	0x1	number_ranks Number of supported memory ranks. 2'b00 = 1 rank 2'b01 = 2 ranks 2'b10 = 3 ranks 2'b11 = 4 ranks
8	RO	0x0	reserved
7:6	RW	0x2	row_addr_width Width of the memory row address bits. 2'b00 = 13 bits wide 2'b01 = 14 bits wide 2'b10 = 15 bits wide 2'b11 = 16 bits wide
5	RO	0x0	reserved
4:3	RW	0x2	bank_addr_width Width of the memory bank address bits. 2'b00 = 2 bits wide (4 banks) 2'b01 = 3 bits wide (8 banks) Others = Reserved
2	RO	0x0	reserved

Bit	Attr	Reset Value	Description
1:0	RW	0x0	column_addr_width Width of the memory column address bits. 2'b00 = 7 bits wide 2'b01 = 8 bits wide 2'b10 = 9 bits wide 2'b11 = 10 bits wide

DDR_PCTL_TOGCNT1U

Address: Operational Base + offset (0x00c0)

Toggle Counter 1us Register

Bit	Attr	Reset Value	Description
31:10	RO	0x0	reserved
9:0	RW	0x064	toggle_counter_1u The number of internal timers clock cycles

DDR_PCTL_TINIT

Address: Operational Base + offset (0x00c4)

t_init Timing Register

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8:0	RW	0x0c8	t_init Defines the time period (in us) to hold dfi_cke and dfi_reset_n stable during the memory power up sequence. The value programmed must correspond to at least 200us. The actual time period defined is TINIT * TOGCNT1U * internal timers clock .period

DDR_PCTL_TRSTH

Address: Operational Base + offset (0x00c8)

t_rsth Timing Register

Bit	Attr	Reset Value	Description
31:10	RO	0x0	reserved

Bit	Attr	Reset Value	Description
9:0	RW	0x000	t_rsth Defines the time period (in us) to hold the dfi_reset_n signal high after it is de-asserted during the DDR3 Power Up/Reset sequence. The value programmed for DDR3 must correspond to minimum 500us of delay. For mDDR and DDR2, this register should be programmed to 0. The actual time period defined is TRSTH * TOGCNT1U * internal timers clock period.

DDR_PCTL_TOGCNT100N

Address: Operational Base + offset (0x00cc)

Toggle Counter 100ns

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6:0	RW	0x01	toggle_counter_100n The number of internal timers clock cycles.

DDR_PCTL_TREFI

Address: Operational Base + offset (0x00d0)

t_refi Timing Register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x01	t_refi Defines the time period (in 100ns units) of the Refresh interval. The actual time period defined is TREFI * TOGCNT100N * internal timers clock period.

DDR_PCTL_TMRD

Address: Operational Base + offset (0x00d4)

t_mrd Timing Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved

Bit	Attr	Reset Value	Description
2:0	RW	0x1	t_mrd Mode Register Set command cycle time in memory clock cycles. mDDR: Time from MRS to any valid command. LPDDR2: Time from MRS (MRW) to any valid command. DDR2: Time from MRS to any valid command. DDR3: Time from MRS to MRS command. mDDR Legal Values: 2 LPDDR2 Legal Values: 5 DDR2 Legal Values: 2..3 DDR3 Legal Values: 2..4

DDR_PCTL_TRFC

Address: Operational Base + offset (0x00d8)

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8:0	RW	0x001	t_rfc Refresh to Active/Refresh command time in memory clock cycles. mDDR Legal Values: 7..28 LPDDR2 Legal Values: 15..112 DDR2 Legal Values: 15..131 DDR3 Legal Values: 36.. 374

DDR_PCTL_TRP

Address: Operational Base + offset (0x00dc)

t_trp Timing Register

Bit	Attr	Reset Value	Description
31:18	RO	0x0	reserved
17:16	RW	0x1	prea_extra Additional cycles required for a Precharge All (PREA) command - in addition to t_rp. In terms of memory clock cycles mDDR Value: 0 LPDDR2 Value: Value that corresponds (tRPab -tRPPb). Rounded up in terms of memory clock cycles. Values can be 0, 1, 2. DDR2 Value: 1 if 8 Banks, 0 otherwise DDR3 Value: 0
15:4	RO	0x0	reserved

Bit	Attr	Reset Value	Description
3:0	RW	0x6	t_rp Precharge period in memory clock cycles. For LPDDR2, this should be set to TRPpb. mDDR Legal Values: 2..3 LPDDR2 Legal Values: 3..13 DDR2 Legal Values: 3..7 DDR3 Legal Values: 5..14

DDR_PCTL_TRTW

Address: Operational Base + offset (0x00e0)

t_rtw Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x2	t_rtw Read to Write turnaround time in memory clock cycles. mDDR Legal Values: 3..11 LPDDR2 Legal Values: 1..11 DDR2 Legal Values: 2..10 DDR3 Legal Values: 2..10

DDR_PCTL_TAL

Address: Operational Base + offset (0x00e4)

AL Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x0	t_al Additive Latency in memory clock cycles. For DDR2 this must match the value programmed into the AL field of MR1. For DDR3 this must be 0, CL-1, CL-2 depending whether the AL value in MR1 is 0,1, or 2 respectively. CL is the CAS latency programmed into MR0. For mDDR and LPDDR2, there is no AL field in the mode registers, and this setting should be set to 0 mDDR Legal Values: 0 LPDDR2 Legal Values: 0 DDR2 Legal Values: AL DDR3 Legal Values: 0, CL-1, CL-2 (depending on AL=0,1,2 in MR1)

DDR_PCTL_TCL

Address: Operational Base + offset (0x00e8)
CL Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x4	t_cl CAS Latency in memory clock cycles. If mDDR/DDR2/DDR3, the PCTL setting must match the value programmed into the CL field of MR0. If LPDDR2, the PCTL setting must match RL (ReadLatency), where RL is the value programmed into the "RL & W" field of MR2. mDDR/DDR2/3 Legal Value: CL LPDDR2 Legal Value: RL

DDR_PCTL_TCWL

Address: Operational Base + offset (0x00ec)
CWL Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x3	t_cwl CAS Write Latency in memory clock cycles. For mDDR, the setting must be 1. For LPDDR2 the setting must match WL (Write Latency), where WL is the value programmed into the "RL & WL" field of MR2. For DDR2 the setting must match CL-1, where CL is the value programmed into the CL field of MR0. For DDR3, the setting must match the value programmed in the memory CWL field of MR2. mDDR Legal Value: 1 LPDDR2 Legal Values: WL DDR2 Legal Value: CL-1 DDR3 Legal Value: CWL

DDR_PCTL_TRAS

Address: Operational Base + offset (0x00f0)
t_ras Timing Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved

Bit	Attr	Reset Value	Description
5:0	RW	0x10	t_ras Activate to Precharge command time in memory clock cycles. mDDR Legal Values: 4..8 LPDDR2 Legal Values: 7..23 DDR2 Legal Values: 8..24 DDR3 Legal Values: 15..38

DDR_PCTL_TRC

Address: Operational Base + offset (0x00f4)

t_rc Timing Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x16	t_rc Row Cycle time in memory clock cycles. Specifies the minimum Activate to Activate distance for accesses to same bank. mDDR Legal Values: 5..11 LPDDR2 Legal Values: 10..36 DDR2 Legal Values: 11..31 DDR3 Legal Values: 20..52

DDR_PCTL_TRCD

Address: Operational Base + offset (0x00f8)

t_rcd Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x6	t_rcd Row to Column delay in memory clock cycles. Specifies the minimum Activate to Column distance. mDDR Legal Values: 2..3 LPDDR2 Legal Values: 3..13 DDR2 Legal Values: 3..7 DDR3 Legal Values: 5..14

DDR_PCTL_TRRD

Address: Operational Base + offset (0x00fc)

t_rrd Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved

Bit	Attr	Reset Value	Description
3:0	RW	0x4	t_rrd Row-to-Row delay in memory clock cycles. Specifies the minimum Activate-to-Activate distance for consecutive accesses to different banks in the same rank. mDDR Legal Values: 1..2 LPDDR2 Legal Values: 2..6 DDR2 Legal Values: 2..6 DDR3 Legal Values: 4..8

DDR_PCTL_TRTP

Address: Operational Base + offset (0x0100)

t_rtp Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x3	t_rtp Read to Precharge time in memory clock cycles. Specifies the minimum distance Read to Precharge for consecutive accesses to same bank. mDDR Value: 0 LPDDR2 Legal Values: 2..4 DDR2 Legal Values: 2..4 DDR3 Legal Values: 3..8

DDR_PCTL_TWR

Address: Operational Base + offset (0x0104)

t_wr Register

Bit	Attr	Reset Value	Description
31:5	RO	0x0	reserved
4:0	RW	0x06	t_wr Write recovery time in memory clock cycles. When using close page the PCTL setting must be consistent with the WR field setting of MR0. mDDR Legal Values: 2..3 LPDDR2 Legal Values: 3..8 DDR2 Legal Values: 3..8 DDR3 Legal Values: 6..16

DDR_PCTL_TWTR

Address: Operational Base + offset (0x0108)

t_wtr Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x4	t_wtr Write to Read turnaround time, in memory clock cycles. mDDR Legal Values: 1..2 LPDDR2 Legal Values: 2..4 DDR2 Legal Values: 2..4 DDR3 Legal Values: 3..8

DDR_PCTL_TEXSR

Address: Operational Base + offset (0x010c)

t_exsr Timing Register

Bit	Attr	Reset Value	Description
31:10	RO	0x0	reserved
9:0	RW	0x001	t_exsr Exit Self Refresh to first valid command delay, in memory clock cycles. For mDDR, this should be programmed to match tXSR. For LPDDR2, this should be programmed to match tXSR. For DDR2, this should be programmed to match tXSRD (SRE to read-related command) as defined by the memory device specification. For DDR3, this should be programmed to match tXSDL (SRE to a command requiring DLL locked) as defined by the memory device specification. mDDR Legal Values: 17..40 LPDDR2 Legal Values: 17..117 DDR2 Typical Value: 200 DDR3 Typical Value: 512

DDR_PCTL_TXP

Address: Operational Base + offset (0x0110)

t_xp Timing Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved

Bit	Attr	Reset Value	Description
2:0	RW	0x1	t_xp Exit Power Down to first valid command delay when DLL is on (fast exit), measured in memory clock cycles. Legal Values: 1..7

DDR_PCTL_TXPDLL

Address: Operational Base + offset (0x0114)

t_xpdll Timing Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x00	t_xpdll Exit Power Down to first valid command delay when DLL is off (slow exit), measured in memory clock cycles. mDDR/LPDDR2 Value: 0 DDR2/DDR3 Legal Values: 3..63

DDR_PCTL_TZQCS

Address: Operational Base + offset (0x0118)

t_zqcs Timing Register

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6:0	RW	0x00	t_zqcs SDRAM ZQ Calibration Short period, in memory clock cycles. Should be programmed to match the tZQCS timing value as defined in the memory specification. mDDR Value: 0 LPDDR2 Legal Values: 15..48 DDR2 Value: 0 DDR3 Typical Value: 64

DDR_PCTL_TZQCSI

Address: Operational Base + offset (0x011c)

t_zqcsi Timing Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	t_zqcsi SDRAM ZQCS interval, measured in Refresh interval units. The total time period defined is TZQCSI*TREFI * TOGCNT100N * internal timers clock period. Programming a value of 0 in t_zqcsi disables the auto-ZQCS functionality in PCTL. mDDR Value: 0 LPDDR2 Legal Values: 0..4294967295 DDR2 Value: 0 DDR3 Legal Values: 0..4294967295

DDR_PCTL_TDQS

Address: Operational Base + offset (0x0120)

t_dqs Timing Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2:0	RW	0x1	t_dqs Additional data turnaround time in memory clock cycles for accesses to different ranks. Used to increase the distance between column commands to different ranks, allowing more tolerance as the driver source changes on the bidirectional DQS and/or DQ signals. mDDR Legal Values: 1..7 LPDDR2 Legal Values: 1..7 DDR2 Legal Values: 1..7 DDR3 Legal Values: 1..7

DDR_PCTL_TCKSRE

Address: Operational Base + offset (0x0124)

t_cksrc Timing Register

Bit	Attr	Reset Value	Description
31:5	RO	0x0	reserved

Bit	Attr	Reset Value	Description
4:0	RW	0x00	t_cksrc In DDR3, this is the time after Self Refresh Entry that CKE is held high before going low. In memory clock cycles. Specifies the clock disable delay after SRE. This should be programmed to match the greatest value between 10ns and 5 memory clock periods. mDDR Value: 0 LPDDR2 Value: 0 DDR2 Value: 0 DDR3 Legal Values: 5..15

DDR_PCTL_TCCKSRX

Address: Operational Base + offset (0x0128)

t_cksrc Timing Register

Bit	Attr	Reset Value	Description
31:5	RO	0x0	reserved
4:0	RW	0x00	t_cksrc In DDR3, this is the time (before Self Refresh Exit) that CKE is maintained high before issuing SRX. In memory clock cycles. Specifies the clock stable time before SRX. This should be programmed to match the greatest value between 10ns and 5 memory clock periods. mDDR Value: 0 LPDDR2 Value: 0 DDR2 Value: 0 DDR3 Legal Values: 5..15

DDR_PCTL_TCKE

Address: Operational Base + offset (0x012c)

t_cke Timing Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2:0	RW	0x3	t_cke CKE minimum pulse width in memory clock cycles. mDDR Legal Value: 2 LPDDR2 Legal Values: 3 DDR2 Legal Value: 3 DDR3 Legal Values: 3..6

DDR_PCTL_TMOD

Address: Operational Base + offset (0x0130)

t_mod Timing Register

Bit	Attr	Reset Value	Description
31:5	RO	0x0	reserved
4:0	RW	0x00	t_mod In DDR3 mode, this is the time from MRS to any valid non-MRS command (except DESELECT or NOP) in memory clock cycles. mDDR Value: 0 LPDDR2 Value: 0 DDR2 Value: 0 DDR3 Legal Values: 0..31

DDR_PCTL_TRSTL

Address: Operational Base + offset (0x0134)

Reset Low Timing Register

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6:0	RW	0x00	t_rstl Memory Reset Low time, in memory clock cycles. Defines the time period to hold dfi_reset_n signal low during a software driven DDR3 Reset Operation. The value programmed must correspond to at least 100ns of delay. mDDR Value: 0 LPDDR2 Value: 0 DDR2 Value: 0 DDR3 Legal Values: 1..127

DDR_PCTL_TZQCL

Address: Operational Base + offset (0x0138)

t_zqcl Timing Register

Bit	Attr	Reset Value	Description
31:10	RO	0x0	reserved

Bit	Attr	Reset Value	Description
9:0	RW	0x000	t_zqcl SDRAM ZQ Calibration Long period in memory clock cycles. If LPDDR2, should be programmed to tZQCL. If DDR3, should be programmed to match the memory tZQinit timing value for the first ZQCL command during memory initialization; should be programmed to match tZQoper timing value after reset and initialization. mDDR Value: 0 LPDDR2 Legal Values: 60..192 DDR2 Value: 0 DDR3 Legal Values: 0..1023

DDR_PCTL_TMRR

Address: Operational Base + offset (0x013c)

t_mrr Timing Register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x02	t_mrr Time for a Mode Register Read (MRR command from MCMD).

DDR_PCTL_TCkesr

Address: Operational Base + offset (0x0140)

t_ckesr Timing Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x4	t_ckesr Minimum CKE low width for Self Refresh entry to exit timing in memory clock cycles. Recommended settings: - mDDR : t_ckesr = 0 - LPDDR2 : t_ckesr = tCKESR setting from memories, rounded up in terms of memory cycles. - DDR2 : t_ckesr = 0 - DDR3 : t_ckesr = t_cke + 1 mDDR Value: 0 LPDDR2 Legal Values: 3..8 DDR2 Value: 0 DDR3 Legal Values: 4..7

DDR_PCTL_TDPD

Address: Operational Base + offset (0x0144)
t_dpd Timing Register

Bit	Attr	Reset Value	Description
31:10	RO	0x0	reserved
9:0	RW	0x000	<p>t_dpd</p> <p>Minimum Deep Power Down time. Is in terms of us.</p> <p>When a MCMD.DPDE command occurs, TDPD time is waited before MCMD.start_cmd can be cleared. MCMD_cmd_add_del (if any) does not start until TDPD has completed. This ensures TDPD requirement for the memory is not violated.</p> <p>The actual time period defined is TDPD* TOGCNT1U * internal timers clock period.</p> <p>Only applies for mDDR and LPDDR2 as Deep Power Down (DPD) is only valid for these memory types.</p> <p>For mDDR, tDPD=0, while for LPDDR2, tDPD=500 us.</p> <p>For LPDDR2, if 500 us is waited externally by system, then set tDPD=0.</p> <p>mDDR Value: 0 LPDDR2 Legal Values: 0 or 500 DDR2 Legal Value: 0 DDR3 Legal Values: 0</p>

DDR_PCTL_DTUWACTL

Address: Operational Base + offset (0x0200)
DTU Write Address Control

Bit	Attr	Reset Value	Description
31:30	RW	0x0	dtu_wr_rank Write rank to where data is to be targeted
29	RO	0x0	reserved
28:13	RW	0x0000	dtu_wr_row Write row to where data is to be targeted
12:10	RW	0x0	dtu_wr_bank Write bank to where data is to be targeted
9:0	RW	0x000	dtu_wr_col FWrite column to where data is to be targeted

DDR_PCTL_DTRACTL

Address: Operational Base + offset (0x0204)

DTU Read Address Control Register

Bit	Attr	Reset Value	Description
31:30	RW	0x0	dtu_rd_rank Read rank from where data comes
29	RO	0x0	reserved
28:13	RW	0x0000	dtu_rd_row Read row from where data comes
12:10	RW	0x0	dtu_rd_bank Read bank from where data comes
9:0	RW	0x000	dtu_rd_col Read column from where data comes

DDR_PCTL_DTUCFG

Address: Operational Base + offset (0x0208)

DTU Configuration Control Register

Bit	Attr	Reset Value	Description
31:23	RO	0x0	reserved
22:16	RW	0x00	dtu_row_increments Number of times to increment the row address when generating random data, up to a maximum of 127 times.
15	RW	0x0	dtu_wr_multi_rd When set puts the DTU into write once multiple reads mode.
14	RW	0x0	dtu_data_mask_en Controls whether random generated data masks are transmitted. Unless enabled all data bytes are written to memory and expected to be read from memory.
13:10	RW	0x0	dtu_target_lane Selects one of the byte lanes for data comparison into the programmable read data buffer.
9	RW	0x0	dtu_generate_random Generate transfers using random data, otherwise generate transfers from the programmable write data buffers.
8	RW	0x0	dtu_incr_banks When the column address rolls over increment the bank address until we reach and conclude bank 7.

Bit	Attr	Reset Value	Description
7	RW	0x0	dtu_incr_cols Increment the column address until we saturate. Return to zero if DTUCFG.dtu_incr_banks is set to 1 and we are not at bank 7.
6:1	RW	0x00	dtu_nalen Length of the NIF transfer sequence that is passed through the PCTL for each created address.
0	RW	0x0	dtu_enable When set, allows the DTU module to take ownership of the NIF interface: 1: DTU enabled 0: DTU disabled

DDR_PCTL_DTUECTL

Address: Operational Base + offset (0x020c)

DTU Execute Control Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2	RWSC	0x0	wr_multi_rd_RST When set, resets the DTU in write once multiple reads mode, to allow a new write to be performed. This bit automatically clears.
1	RWSC	0x0	run_error_reports When set, initiates the calculation of the error status bits. This bit automatically clears when the re-calculation is done. This is only used in debug mode to verify the comparison logic.
0	RWSC	0x0	run_dtu When set, initiates the running of the DTU read and write transfer. This bit automatically clears when the transfers are completed

DDR_PCTL_DTUWDO

Address: Operational Base + offset (0x0210)

DTU Write Data #0 Register

Bit	Attr	Reset Value	Description
31:24	RW	0x00	dtu_wr_byte3 Write data byte
23:16	RW	0x00	dtu_wr_byte2 Write data byte

Bit	Attr	Reset Value	Description
15:8	RW	0x00	dtu_wr_byte1 Write data byte
7:0	RW	0x00	dtu_wr_byte0 Write data byte

DDR_PCTL_DTUWD1

Address: Operational Base + offset (0x0214)

DTU Write Data #1 Register

Bit	Attr	Reset Value	Description
31:24	RW	0x00	dtu_wr_byte7 Write data byte
23:16	RW	0x00	dtu_wr_byte6 Write data byte
15:8	RW	0x00	dtu_wr_byte5 Write data byte
7:0	RW	0x00	dtu_wr_byte4 Write data byte

DDR_PCTL_DTUWD2

Address: Operational Base + offset (0x0218)

DTU Write Data #2 Register

Bit	Attr	Reset Value	Description
31:24	RW	0x00	dtu_wr_byte11 Write data byte
23:16	RW	0x00	dtu_wr_byte10 Write data byte
15:8	RW	0x00	dtu_wr_byte9 Write data byte
7:0	RW	0x00	dtu_wr_byte8 Write data byte

DDR_PCTL_DTUWD3

Address: Operational Base + offset (0x021c)

DTU Write Data #3 Register

Bit	Attr	Reset Value	Description
31:24	RW	0x00	dtu_wr_byte15 Write data byte
23:16	RW	0x00	dtu_wr_byte14 Write data byte
15:8	RW	0x00	dtu_wr_byte13 Write data byte

Bit	Attr	Reset Value	Description
7:0	RW	0x00	dtu_wr_byte12 Write data byte

DDR_PCTL_DTUWDM

Address: Operational Base + offset (0x0220)

DTU Write Data Mask Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	dm_wr_byte0 Write data mask bit, one bit for each byte. Each bit should be 0 for a byte lane that contains valid write data.

DDR_PCTL_DTURD0

Address: Operational Base + offset (0x0224)

DTU Read Data #0 Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	dtu_rd_byte3 Read byte
23:16	RO	0x00	dtu_rd_byte2 Read byte
15:8	RO	0x00	dtu_rd_byte1 Read byte
7:0	RO	0x00	dtu_rd_byte0 Read byte

DDR_PCTL_DTURD1

Address: Operational Base + offset (0x0228)

DTU Read Data #1 Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	dtu_rd_byte7 Read byte
23:16	RO	0x00	dtu_rd_byte6 Read byte
15:8	RO	0x00	dtu_rd_byte5 Read byte
7:0	RO	0x00	dtu_rd_byte4 Read byte

DDR_PCTL_DTURD2

Address: Operational Base + offset (0x022c)

DTU Read Data #2 Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	dtu_rd_byte11 Read byte
23:16	RO	0x00	dtu_rd_byte10 Read byte
15:8	RO	0x00	dtu_rd_byte9 Read byte
7:0	RO	0x00	dtu_rd_byte8 Read byte

DDR_PCTL_DTURD3

Address: Operational Base + offset (0x0230)

DTU Read Data #3 Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	dtu_rd_byte15 Read byte
23:16	RO	0x00	dtu_rd_byte14 Read byte
15:8	RO	0x00	dtu_rd_byte13 Read byte
7:0	RO	0x00	dtu_rd_byte12 Read byte

DDR_PCTL_DTULFSRWD

Address: Operational Base + offset (0x0234)

DTU LFSR Seed for Write Data Generation Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dtu_lfsr_wseed This is the initial seed for the random write data generation LFSR (linear feedback shift register), shared with the write mask generation.

DDR_PCTL_DTULFSRRD

Address: Operational Base + offset (0x0238)

DTU LFSR Seed for Read Data Generation Register

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dtu_lfsr_rseed This is the initial seed for the random read data generation LFSR (linear feedback shift register), this is shared with the read mask generation. The read data mask is reconstructed the same as the write data mask was created, allowing the "on the fly comparison" ignore bytes which were not written.

DDR_PCTL_DTUEAF

Address: Operational Base + offset (0x023c)
DTU Error Address FIFO Register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	ea_rank Indicates the rank that the error occurred in during random data generation. There could be a number of entries in this FIFO. If FIFO is empty one reads zeroes.
29	RO	0x0	reserved
28:13	RO	0x0000	ea_row Indicates the row that the error occurred in during random data generation. There could be a number of entries in this FIFO. If FIFO is empty one reads zeroes.
12:10	RO	0x0	ea_bank Indicates the bank that the error occurred in during random data generation. There could be a number of entries in this FIFO. If FIFO is empty one reads zeroes
9:0	RO	0x000	ea_column Indicates the column address that the error occurred in during random data generation. There could be a number of entries in this FIFO. If FIFO is empty one reads zeroes.

DDR_PCTL_DFITCTRLDELAY

Address: Operational Base + offset (0x0240)
DFI tctrl_delay Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved

Bit	Attr	Reset Value	Description
3:0	RW	0x2	tctrl_delay Specifies the number of DFI clock cycles after an assertion or deassertion of the DFI control signals that the control signals at the PHY-DRAM interface reflect the assertion or de-assertion. If the DFI clock and the memory clock are not phase-aligned, this timing parameter should be rounded up to the next integer value.

DDR_PCTL_DFIODTCFG

Address: Operational Base + offset (0x0244)

DFI ODT Configuration

Bit	Attr	Reset Value	Description
31:29	RO	0x0	reserved
28	RW	0x0	rank3_odt_default Default ODT value of rank 3 when there is no read/write activity
27	RW	0x0	rank3_odt_write_sel Enable/disable ODT for rank 3 when a write access is occurring on this rank
26	RW	0x0	rank3_odt_write_nse Enable/disable ODT for rank 3 when a write access is occurring on a different rank
25	RW	0x0	rank3_odt_read_sel Enable/disable ODT for rank 3 when a read access is occurring on this rank
24	RW	0x0	rank3_odt_read_nsel Enable/disable ODT for rank 3 when a read access is occurring on a different rank
23:21	RO	0x0	reserved
20	RW	0x0	rank2_odt_default Default ODT value of rank 2 when there is no read/write activity
19	RW	0x0	rank2_odt_write_sel Enable/disable ODT for rank 2 when a write access is occurring on this rank
18	RW	0x0	rank2_odt_write_nse Enable/disable ODT for rank 2 when a write access is occurring on a different rank

Bit	Attr	Reset Value	Description
17	RW	0x0	rank2_odt_read_sel Enable/disable ODT for rank 2 when a read access is occurring on this rank
16	RW	0x0	rank2_odt_read_nsel Enable/disable ODT for rank 2 when a read access is occurring on a different rank
15:13	RO	0x0	reserved
12	RW	0x0	rank1_odt_default Default ODT value of rank 1 when there is no read/write activity
11	RW	0x0	rank1_odt_write_sel Enable/disable ODT for rank 1 when a write access is occurring on this rank
10	RW	0x0	rank1_odt_write_nse Enable/disable ODT for rank 1 when a write access is occurring on a different rank
9	RW	0x0	rank1_odt_read_sel Enable/disable ODT for rank 1 when a read access is occurring on this rank
8	RW	0x0	rank1_odt_read_nsel Enable/disable ODT for rank 1 when a read access is occurring on a different rank
7:5	RO	0x0	reserved
4	RW	0x0	rank0_odt_default Default ODT value of rank 0 when there is no read/write activity
3	RW	0x0	rank0_odt_write_sel Enable/disable ODT for rank 0 when a write access is occurring on this rank
2	RW	0x0	rank0_odt_write_nse Enable/disable ODT for rank 0 when a write access is occurring on a different rank
1	RW	0x0	rank0_odt_read_sel Enable/disable ODT for rank 0 when a read access is occurring on this rank
0	RW	0x0	rank0_odt_read_nsel Enable/disable ODT for rank 0 when a read access is occurring on a different rank

DDR_PCTL_DFIODTCFG1

Address: Operational Base + offset (0x0248)

DFI ODT Timing Configuration 1 (for Latency and Length)

Bit	Attr	Reset Value	Description
31:27	RO	0x0	reserved
26:24	RW	0x6	ODT length for BL8 read transfers Length of dfi_odt signal for BL8 reads. This is in terms of SDR cycles. For BL4 reads, the length of dfi_odt is always 2 cycles shorter than the value in this register field.
23:19	RO	0x0	reserved
18:16	RW	0x6	ODT length for BL8 write transfers Length of dfi_odt signal for BL8 writes. This is in terms of SDR cycles. For BL4 writes, the length of dfi_odt is always 2 cycles shorter than the value in this register field.
15:13	RO	0x0	reserved
12:8	RW	0x00	ODT latency for reads Latency after a read command that dfi_odt is set. This is in terms of SDR cycles.
7:5	RO	0x0	reserved
4:0	RW	0x00	ODT latency for writes Latency after a write command that dfi_odt is set. This is in terms of SDR cycles

DDR_PCTL_DFIODTRANKMAP

Address: Operational Base + offset (0x024c)

DFI ODT Rank Mapping

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:12	RW	0x8	Rank mapping for dfi_odt[3] Determines whether dfi_odt[3] should be asserted when the PCTL requires to terminate each rank Bit 15 = 1: dfi_odt[3] will be asserted to terminate rank 3 Bit 14 = 1: dfi_odt[3] will be asserted to terminate rank 2 Bit 13 = 1: dfi_odt[3] will be asserted to terminate rank 1 Bit 12 = 1: dfi_odt[3] will be asserted to terminate rank 0 This field exists only if PCTL_M_NRANKS = 4

Bit	Attr	Reset Value	Description
11:8	RW	0x4	<p>Rank mapping for dfi_odt[2]</p> <p>Determines which rank access(es) will cause dfi_odt[2] to be asserted</p> <p>Bit 11 = 1: dfi_odt[2] will be asserted to terminate rank 3</p> <p>Bit 10 = 1: dfi_odt[2] will be asserted to terminate rank 2</p> <p>Bit 9 = 1: dfi_odt[2] will be asserted to terminate rank 1</p> <p>Bit 8 = 1: dfi_odt[2] will be asserted to terminate rank 0</p> <p>This field exists only if PCTL_M_NRANKS = 4</p>
7:4	RW	0x2	<p>Rank mapping for dfi_odt[1]</p> <p>Determines which rank access(es) will cause dfi_odt[1] to be asserted</p> <p>Bit 7= 1: dfi_odt[1] will be asserted to terminate rank 3</p> <p>Bit 6= 1: dfi_odt[1] will be asserted to terminate rank 2</p> <p>Bit 5= 1: dfi_odt[1] will be asserted to terminate rank 1</p> <p>Bit 4= 1: dfi_odt[1] will be asserted to terminate rank 0</p> <p>This field exists only if PCTL_M_NRANKS ></p>
3:0	RW	0x1	<p>Rank mapping for dfi_odt[0]</p> <p>Determines which rank access(es) will cause dfi_odt[0] to be asserted</p> <p>Bit 3= 1: dfi_odt[0] will be asserted to terminate rank 3</p> <p>Bit 2= 1: dfi_odt[0] will be asserted to terminate rank 2</p> <p>Bit 1= 1: dfi_odt[0] will be asserted to terminate rank 1</p> <p>Bit 0= 1: dfi_odt[0] will be asserted to terminate rank 0</p>

DDR_PCTL_DFITPHYWRDATA

Address: Operational Base + offset (0x0250)

DFI tphy_wrdata Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved

Bit	Attr	Reset Value	Description
5:0	RW	0x01	tphy_wrdata Specifies the number of DFI clock cycles between when the dfi_wrdata_en signal is asserted to when the associated write data is driven on the dfi_wrdata signal. This has no impact on performance, only adjusts the relative time between enable and data transfer.

DDR_PCTL_DFITPHYWRLAT

Address: Operational Base + offset (0x0254)

DFI tphy_wrlat Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x01	tphy_wrlat Specifies the number of DFI clock cycles between when a write command is sent on the DFI control interface and when the dfi_wrdata_en signal is asserted.

DDR_PCTL_DFITRDDATAEN

Address: Operational Base + offset (0x0260)

DFI trddata_en Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x01	trddata_en Specifies the number of DFI clock cycles from the assertion of a read command on the DFI to the assertion of the dfi_rddata_en signal.

DDR_PCTL_DFITPHYRDLAT

Address: Operational Base + offset (0x0264)

DFI tphy_rdlat Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x0f	tphy_rdlat Specifies the maximum number of DFI clock cycles allowed from the assertion of the dfi_rddata_en signal to the assertion of the dfi_rddata_valid signal.

DDR_PCTL_DFITPHYUPDTYPE0

Address: Operational Base + offset (0x0270)

DFI tphyupd_type0 Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0x010	tphyupd_type0 Specifies the maximum number of DFI clock cycles that the dfi_phyupd_req signal may remain asserted after the assertion of the dfi_phyupd_ack signal for dfi_phyupd_type = 0x0. The dfi_phyupd_req signal may de-assert at any cycle after the assertion of the dfi_phyupd_ack signal.

DDR_PCTL_DFITPHYUPDTYPE1

Address: Operational Base + offset (0x0274)

DFI tphyupd_type1 Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0x010	tphyupd_type1 Specifies the maximum number of DFI clock cycles that the dfi_phyupd_req signal may remain asserted after the assertion of the dfi_phyupd_ack signal for dfi_phyupd_type = 0x1. The dfi_phyupd_req signal may de-assert at any cycle after the assertion of the dfi_phyupd_ack signal.

DDR_PCTL_DFITPHYUPDTYPE2

Address: Operational Base + offset (0x0278)

DFI tphyupd_type2 Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0x010	tphyupd_type2 Specifies the maximum number of DFI clock cycles that the dfi_phyupd_req signal may remain asserted after the assertion of the dfi_phyupd_ack signal for dfi_phyupd_type = 0x2. The dfi_phyupd_req signal may de-assert at any cycle after the assertion of the dfi_phyupd_ack signal.

DDR_PCTL_DFITPHYUPDTYPE3

Address: Operational Base + offset (0x027c)

DFI tphyupd_type3 Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0x010	tphyupd_type3 Specifies the maximum number of DFI clock cycles that the dfi_phyupd_req signal may remain asserted after the assertion of the dfi_phyupd_ack signal for dfi_phyupd_type = 0x3. The dfi_phyupd_req signal may de-assert at any cycle after the assertion of the dfi_phyupd_ack signal.

DDR_PCTL_DFITCTRLUPDMIN

Address: Operational Base + offset (0x0280)

DFI tctrlupd_min Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0010	tctrlupd_min Specifies the minimum number of DFI clock cycles that the dfi_ctrlupd_req signal must be asserted.

DDR_PCTL_DFITCTRLUPDMAX

Address: Operational Base + offset (0x0284)

DFI tctrlupd_max Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0040	tctrlupd_max Specifies the maximum number of DFI clock cycles that the dfi_ctrlupd_req signal can assert.

DDR_PCTL_DFITCTRLUPDDLY

Address: Operational Base + offset (0x0288)

DFI tctrlupddly Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x8	tctrlupd_dly Delay in DFI clock cycles between time a PCTL-initiated update could be started and time PCTL-initiated update actually starts (dfi_ctrlupd_req going high).

DDR_PCTL_DFIUPDCFG

Address: Operational Base + offset (0x0290)

DFI Update Configuration Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x1	<p>dfi_phyupd_en Enables the support for acknowledging PHY-initiated updates: 1'b0 = Disabled 1'b1 = Enabled</p>
0	RW	0x1	<p>dfi_ctrlupd_en Enables the generation of PCTL-initiated updates: 1'b0 = Disabled 1'b1 = Enabled</p>

DDR_PCTL_DFITREFMSKI

Address: Operational Base + offset (0x0294)

DFI Masked Refresh Interval

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x00	<p>trefmski Time period of the masked Refresh interval. This value is only used if TREFI==0. Defines the time period (in 100ns units) of the masked Refresh (REFMSK) interval. The actual time period defined is DFITREFMSKI* TOGCNT100N * internal timers clock period.</p>

DDR_PCTL_DFITCTRLUPDI

Address: Operational Base + offset (0x0298)

DFI tctrlupd_interval Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	tctrlupd_interval DFI PCTL-initiated updates interval, measured in terms of Refresh interval units. If TREFI!=0, the time period is defined as DFITCTRLUPDI*TREFI * TOGCNT100N * internal timers clock period. If TREFI==0 and DFITREFMSKI!=0, the period changes to DFITCTRLUPDI*DFITREFMSKI* * TOGCNT100N * internal timers clock period. Programming a value of 0 is the same as programming a value of 1; for instance, a PCTL-initiated update occurs every Refresh interval.

DDR_PCTL_DFITRCFG0

Address: Operational Base + offset (0x02ac)

DFI Training Configuration 0 Register

Bit	Attr	Reset Value	Description
31:20	RO	0x0	reserved
19:16	RW	0x0	dfi_wrlvl_rank_sel Determines the value to drive on the output signal dfi_wrlvl_cs_n. The value on dfi_wrlvl_cs_n is the inverse of the setting in this field.
15:13	RO	0x0	reserved
12:4	RW	0x000	dfi_rdlvl_edge Determines the value to drive on the output signal dfi_rdlvl_edge. The value on dfi_rdlvl_edge is the same as the setting in this field.
3:0	RW	0x0	dfi_rdlvl_rank_sel Determines the value to drive on the output signal dfi_rdlvl_cs_n. The value on dfi_rdlvl_cs_n is the inverse of the setting in this field.

DDR_PCTL_DFISTRSTAT0

Address: Operational Base + offset (0x02b0)

DFI Training Status 0 Register

Bit	Attr	Reset Value	Description
31:18	RO	0x0	reserved

Bit	Attr	Reset Value	Description
17:16	RO	0x0	dfi_wrlvl_mode Reports the value of the input signal dfi_wrlvl_mode.
15:10	RO	0x0	reserved
9:8	RO	0x0	dfi_rdlvl_gate_mode Reports the value of the input signal dfi_rdlvl_gate_mode.
7:2	RO	0x0	reserved
1:0	RO	0x0	dfi_rdlvl_mode Reports the value of the input signal dfi_rdlvl_mode.

DDR_PCTL_DFITRWRLVLEN

Address: Operational Base + offset (0x02b4)

DFI Training dfi_wrlvl_en Register

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8:0	RW	0x000	dfi_wrlvl_en Determines the value to drive on the output signal dfi_wrlvl_en.

DDR_PCTL_DFITRRDLVLEN

Address: Operational Base + offset (0x02b8)

DFI Training dfi_rdlvl_en Register

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8:0	RW	0x000	dfi_rdlvl_en Determines the value to drive on the output signal dfi_rdlvl_en.

DDR_PCTL_DFITRRDLVLGATEEN

Address: Operational Base + offset (0x02bc)

DFI Training dfi_rdlvl_gate_en Register

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved
8:0	RW	0x000	dfi_rdlvl_gate_en Determines the value to drive on the output signal dfi_rdlvl_gate_en.

DDR_PCTL_DFISTSTAT0

Address: Operational Base + offset (0x02c0)

DFI Status Status 0 Register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved
24:16	RO	0x000	dfi_data_byte_disable Reports the value of the output signal dfi_data_byte_disable.
15:6	RO	0x0	reserved
5:4	RO	0x0	dfi_freq_ratio Reports the value of the output signal dfi_freq_ratio.
3:2	RO	0x0	reserved
1	RO	0x0	dfi_init_start Reports the value of the output signal dfi_init_start.
0	RO	0x0	dfi_init_complete Reports the value of the input signal dfi_init_complete.

DDR_PCTL_DFISTCFG0

Address: Operational Base + offset (0x02c4)

DFI Status Configuration 0 Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2	RW	0x0	dfi_data_byte_disable_en Enables the driving of the dfi_data_byte_disable signal. The value driven on dfi_data_byte_disable is dependent on the setting of PPCFG register. 1'b0 - Drive dfi_data_byte_disable to default value of all zeroes. 1'b1 - Drive dfi_data_byte_disable according to value as defined by PPCFG register setting. Note: should be set to 1 only after PPCFG is correctly set.

Bit	Attr	Reset Value	Description
1	RW	0x0	<p>dfi_freq_ratio_en Enables the driving of the dfi_freq_ratio signal. When enabled, the dfi_freq_ratio value driven is dependent on configuration parameter PCTL_FREQ_RATIO: 2'b00 is driven when PCTL_FREQ_RATIO=1; 2'b01 is driven when PCTL_FREQ_RATIO=2.</p> <p>1'b0 - Drive dfi_freq_ratio to default value of 2'b00. 1'b1 - Drive dfi_freq_ratio value according to how configuration parameter is set.</p>
0	RW	0x0	<p>dfi_init_start Sets the value of the dfi_init_start signal. 1'b0 - dfi_init_start is driven low 1'b1 - dfi_init_start is driven high</p>

DDR_PCTL_DFISTCFG1

Address: Operational Base + offset (0x02c8)

DFI Status Configuration 1 Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x0	<p>dfi_dram_clk_disable_en_dpd Enables support of the dfi_dram_clk_disable signal with Deep Power Down (DPD). DPD is only for mDDR/LPDDR2.</p> <p>1'b0 - Disable dfi_dram_clk_disable support in relation to DPD 1'b1 - Enable dfi_dram_clk_disable support in relation to DPD</p>
0	RW	0x0	<p>dfi_dram_clk_disable_en Enables support of the dfi_dram_clk_disable signal with Self Refresh (SR).</p> <p>1'b0 - Disable dfi_dram_clk_disable support in relation to SR 1'b1 - Enable dfi_dram_clk_disable support in relation to SR</p>

DDR_PCTL_DFITDRAMCLKEN

Address: Operational Base + offset (0x02d0)

DFI tdram_clk_enable Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved

Bit	Attr	Reset Value	Description
3:0	RW	0x2	t dram_clk_enable Specifies the number of DFI clock cycles from the de-assertion of the d fi_dram_clk_disable signal on the DFI until the first valid rising edge of the clock to the DRAM memory devices, at the PHY-DRAM boundary. If the DFI clock and the memory clock are not phasealigned, this timing parameter should be rounded up to the next integer value.

DDR_PCTL_DFITDRAMCLKDIS

Address: Operational Base + offset (0x02d4)

DFI t dram_clk_disable Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x2	t dram_clk_disable Specifies the number of DFI clock cycles from the assertion of the d fi_dram_clk_disable signal on the DFI until the clock to the DRAM memory devices, at the PHY-DRAM boundary, maintains a low value. If the DFI clock and the memory clock are not phasealigned, this timing parameter should be rounded up to the next integer value.

DDR_PCTL_DFIISTCFG2

Address: Operational Base + offset (0x02d8)

DFI Status Configuration 2 Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x0	parity_en Enables the DFI parity generation feature (driven on output signal d fi_parity_in) 1'b0 - Disable DFI parity generation 1'b1 - Enable DFI parity generation
0	RW	0x0	parity_intr_en Enable interrupt generation for DFI parity error (from input signal d fi_parity_error). 1'b0 - Disable interrupt 1'b1 - Enable interrupt

DDR_PCTL_DFIISTPARCLR

Address: Operational Base + offset (0x02dc)

DFI Status Parity Clear Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RWSC	0x0	<p>parity_log_clr Set this bit to 1'b1 to clear the DFI Status Parity Log register (DFISTPARLOG). 1'b0 = Do not clear DFI status Parity Log register 1'b1 = Clear DFI status Parity Log register</p>
0	RWSC	0x0	<p>parity_intr_clr Set this bit to 1'b1 to clear the interrupt generated by an DFI parity error (as enabled by DFISTCFG2.parity_intr_en). It also clears the INTRSTAT.parity_intr register field. It is automatically cleared by hardware when the interrupt has been cleared.</p>

DDR_PCTL_DFISTPARLOG

Address: Operational Base + offset (0x02e0)

DFI Status Parity Log Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	<p>parity_err_cnt Increments any time the DFI parity logic detects a parity error(s) (on dfi_parity_error).</p>

DDR_PCTL_DFILPCFG0

Address: Operational Base + offset (0x02f0)

DFI Low Power Configuration 0 Register

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:28	RW	0x0	<p>dfi_lp_wakeup_dpd</p> <p>Value to drive on dfi_lp_wakeup signal when Deep Power Down mode is entered.</p> <p>Determines the DFI's tlp_wakeup time:</p> <ul style="list-style-type: none"> 4'b0000 - 16 cycles 4'b0001 - 32 cycles 4'b0010 - 64 cycles 4'b0011 - 128 cycles 4'b0100 - 256 cycles 4'b0101 - 512 cycles 4'b0110 - 1024 cycles 4'b0111 - 2048 cycles 4'b1000 - 4096 cycles 4'b1001 - 8192 cycles 4'b1010 - 16384 cycles 4'b1011 - 32768 cycles 4'b1100 - 65536 cycles 4'b1101 - 131072 cycles 4'b1110 - 262144 cycles 4'b1111 - Unlimited
27:25	RO	0x0	reserved
24	RW	0x0	<p>dfi_lp_en_dpd</p> <p>Enables DFI Low Power interface handshaking during Deep Power Down Entry/Exit.</p> <p>1'b0 - Disabled 1'b1 - Enabled</p>
23:20	RO	0x0	reserved
19:16	RW	0x7	<p>dfi_tlp_resp</p> <p>Setting for tlp_resp time.</p> <p>Same value is used for both Power Down and Self refresh and Deep Power Down modes.</p> <p>DFI 2.1 specification, recommends using value of 7 always.</p>

Bit	Attr	Reset Value	Description
15:12	RW	0x0	<p>dfi_lp_wakeup_sr</p> <p>Value to drive on dfi_lp_wakeup signal when Self Refresh mode is entered.</p> <p>Determines the DFI's tlp_wakeup time:</p> <ul style="list-style-type: none"> 4'b0000 - 16 cycles 4'b0001 - 32 cycles 4'b0010 - 64 cycles 4'b0011 - 128 cycles 4'b0100 - 256 cycles 4'b0101 - 512 cycles 4'b0110 - 1024 cycles 4'b0111 - 2048 cycles 4'b1000 - 4096 cycles 4'b1001 - 8192 cycles 4'b1010 - 16384 cycles 4'b1011 - 32768 cycles 4'b1100 - 65536 cycles 4'b1101 - 131072 cycles 4'b1110 - 262144 cycles 4'b1111 - Unlimited
11:9	RO	0x0	reserved
8	RW	0x0	<p>dfi_lp_en_sr</p> <p>Enables DFI Low Power interface handshaking during Self Refresh Entry/Exit.</p> <p>1'b0 - Disabled</p> <p>1'b1 - Enabled</p>

Bit	Attr	Reset Value	Description
7:4	RW	0x0	<p>dfi_lp_wakeup_pd Value to drive on dfi_lp_wakeup signal when Power Down mode is entered. Determines the DFI's tlp_wakeup time: 4'b0000 - 16 cycles 4'b0001 - 32 cycles 4'b0010 - 64 cycles 4'b0011 - 128 cycles 4'b0100 - 256 cycles 4'b0101 - 512 cycles 4'b0110 - 1024 cycles 4'b0111 - 2048 cycles 4'b1000 - 4096 cycles 4'b1001 - 8192 cycles 4'b1010 - 16384 cycles 4'b1011 - 32768 cycles 4'b1100 - 65536 cycles 4'b1101 - 131072 cycles 4'b1110 - 262144 cycles 4'b1111 - Unlimited</p>
3:1	RO	0x0	reserved
0	RW	0x0	<p>dfi_lp_en_pd Enables DFI Low Power interface handshaking during Power Down Entry/Exit. 1'b0 - Disabled 1'b1 - Enabled</p>

DDR_PCTL_DFITRWRLVLRESP0

Address: Operational Base + offset (0x0300)

DFI Training dfi_wrlvl_resp Status 0 Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	<p>dfi_wrlvl_resp0 Reports the status of the dif_wrlvl_resp[31:0] signal.</p>

DDR_PCTL_DFITRWRLVLRESP1

Address: Operational Base + offset (0x0304)

DFI Training dfi_wrlvl_resp Status 1 Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	<p>dfi_wrlvl_resp1 Reports the status of the dif_wrlvl_resp[63:32] signal.</p>

DDR_PCTL_DFITRWRLVLRESP2

Address: Operational Base + offset (0x0308)
 DFI Training dfi_wrlvl_resp Status 2 Register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RO	0x00	dfi_wrlvl_resp2 Reports the status of the dif_wrlvl_resp[71:64] signal.

DDR_PCTL_DFITRRDLVLRESP0

Address: Operational Base + offset (0x030c)
 DFI Training dfi_rdlvl_resp Status 0 Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	dfi_rdlvl_resp0 Reports the status of the dif_rdlvl_resp[31:0] signal.

DDR_PCTL_DFITRRDLVLRESP1

Address: Operational Base + offset (0x0310)
 DFI Training dfi_rdlvl_resp Status 1 Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	dfi_rdlvl_resp1 Reports the status of the dif_rdlvl_resp[63:32] signal.

DDR_PCTL_DFITRRDLVLRESP2

Address: Operational Base + offset (0x0314)
 DFI Training dfi_rdlvl_resp Status 2 Register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RO	0x00	dfi_rdlvl_resp2 Reports the status of the dif_rdlvl_resp[71:64] signal.

DDR_PCTL_DFITRWRLVLDELAY0

Address: Operational Base + offset (0x0318)
 DFI Training dfi_wrlvl_delay Configuration 0 Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dfi_wrlvl_delay0 Sets the value to be driven on the signal dfi_wrlvl_delay_x[31:0].

DDR_PCTL_DFITRWRLVLDELAY1

Address: Operational Base + offset (0x031c)

DFI Training dfi_wrlvl_delay Configuration 1 Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dfi_wrlvl_delay1 Sets the value to be driven on the signal dfi_wrlvl_delay_x[63:32].

DDR_PCTL_DFITRWRLVLDELAY2

Address: Operational Base + offset (0x0320)

DFI Training dfi_wrlvl_delay Configuration 2 Register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x00	dfi_wrlvl_delay2 Sets the value to be driven on the signal dfi_wrlvl_delay_x[71:64].

DDR_PCTL_DFITRRDLVLDELAY0

Address: Operational Base + offset (0x0324)

DFI Training dfi_rdlvl_delay Configuration 0 Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dfi_rdlvl_delay0 Sets the value to be driven on the signal dfi_rdlvl_delay_x[31:0].

DDR_PCTL_DFITRRDLVLDELAY1

Address: Operational Base + offset (0x0328)

DFI Training dfi_rdlvl_delay Configuration 1 Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dfi_rdlvl_delay1 Sets the value to be driven on the signal dfi_rdlvl_delay_x[63:32].

DDR_PCTL_DFITRRDLVLDELAY2

Address: Operational Base + offset (0x032c)

DFI Training dfi_rdlvl_delay Configuration 2 Register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x00	dfi_rdlvl_delay2 Sets the value to be driven on the signal dfi_rdlvl_delay_x[71:64].

DDR_PCTL_DFITRRDLVLGATEDELAY0

Address: Operational Base + offset (0x0330)

DFI Training dfi_rdlvl_gate_delay Configuration 0

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dfi_rdlvl_gate_delay0 Sets the value to be driven on the signal dfi_rdlvl_gate_delay_x[31:0].

DDR_PCTL_DFITRRDLVLGATEDELAY1

Address: Operational Base + offset (0x0334)

DFI Training dfi_rdlvl_gate_delay Configuration 1

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	dfi_rdlvl_gate_delay1 Sets the value to be driven on the signal dfi_rdlvl_gate_delay_x[63:32].

DDR_PCTL_DFITRRDLVLGATEDELAY2

Address: Operational Base + offset (0x0338)

DFI Training dfi_rdlvl_gate_delay Configuration 2

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x00	dfi_rdlvl_gate_delay2 Sets the value to be driven on the signal dfi_rdlvl_gate_delay_x[71:64].

DDR_PCTL_DFITRCMD

Address: Operational Base + offset (0x033c)

DFI Training Command Register

Bit	Attr	Reset Value	Description
31	RWSC	0x0	dfitrcmd_start DFI Training Command Start. When this bit is set to 1, the command operation defined in the dfitrcmd_opcode field is started. This bit is automatically cleared by the PCTL after the command is finished. The application can poll this bit to determine when PCTL is ready to accept another command. This bit cannot be cleared to 1'b0 by software.
30:13	RO	0x0	reserved
12:4	RW	0x000	dfitrcmd_en DFI Training Command Enable. Selects which bits of chosen DFI Training command to drive to 1'b1.
3:2	RO	0x0	reserved

Bit	Attr	Reset Value	Description
1:0	RW	0x0	dfitrcmd_opcode DFI Training Command Opcode. Select which DFI Training command to generate for one n_clk cycle: 2'b00 - dfi_wrlvl_load 2'b01 - dfi_wrlvl_strobe 2'b10 - dfi_rdlvl_load 2'b11 - Reserved.

DDR_PCTL_IPVR

Address: Operational Base + offset (0x03f8)

IP Version Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	ip_version ASCII value for each number in the version, followed by a *.

DDR_PCTL_IPTR

Address: Operational Base + offset (0x03fc)

IP Type Register

Bit	Attr	Reset Value	Description
31:0	RO	0x44574300	ip_type Contains the IP's identification code, which is an ASCII value to identify the component and it is currently set to the string "DWC". This value never changes.

DDR_PHYCTL_RIDR

Address: Operational Base + offset (0x0000)

Revision Identification Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	UDRID User-Defined Revision ID: General purpose revision identification set by the user.
23:20	RO	0x1	PHYMJR PHY Major Revision: Indicates major revision of the PHY such addition of the features that make the new version not compatible with previous versions.

Bit	Attr	Reset Value	Description
19:16	RO	0x0	PHYMDR PHY Moderate Revision: Indicates moderate revision of the PHY such as addition of new features. Normally the new version is still compatible with previous versions.
15:12	RO	0x0	PHYMNR PHY Minor Revision: Indicates minor update of the PHY such as bug fixes. Normally no new features are included.
11:8	RO	0x1	PUBMJR PUB Major Revision: Indicates major revision of the PUB such addition of the features that make the new version not compatible with previous versions.
7:4	RO	0x4	PUBMDR PUB Moderate Revision: Indicates moderate revision of the PUB such as addition of new features. Normally the new version is still compatible with previous versions.
3:0	RO	0x0	PUBMNR PUB Minor Revision: Indicates minor update of the PUB such as bug fixes. Normally no new features are included.

DDR_PHYCTL_PIR

Address: Operational Base + offset (0x0004)

PHY Initialization Register

Bit	Attr	Reset Value	Description
31	RWSC	0x0	INITBYP Initialization Bypass: Bypasses or stops, if set, all initialization routines currently running, including PHY initialization, DRAM initialization, and PHY training. Initialization may be triggered manually using INIT and the other relevant bits of the PIR register. This bit is self-clearing.
30	RWSC	0x0	ZCALBYP Impedance Calibration Bypass: Bypasses or stops, if set, impedance calibration of all ZQ control blocks that automatically triggers after reset. Impedance calibration may be triggered manually using INIT and ZCAL bits of the PIR register. This bit is self-clearing.

Bit	Attr	Reset Value	Description
29	RWSC	0x0	<p>LOCKBYP DLL Lock Bypass: Bypasses or stops, if set, the waiting of DLLs to lock. DLL lock wait is automatically triggered after reset. DLL lock wait may be triggered manually using INIT and DLLLOCK bits of the PIR register. This bit is self-clearing.</p>
28	RWSC	0x0	<p>CLRSR Clear Status Registers: A write of '1' to this bit will clear (reset to '0' all status registers, including PGSR and DXnGSR. The clear status register bit is self-clearing. This bit is primarily for debug purposes and is typically not needed during normal functional operation. It can be used when PGSR.IDONE=1, to manually clear the PGSR status bits, although starting a new init process will automatically clear the PGSR status bits. Or it can be used to manually clear the DXnGSR status bits, although starting a new data training process will automatically clear the DXnGSR status bits.</p>
27:19	RO	0x0	reserved
18	RW	0x0	<p>CTLDINIT Controller DRAM Initialization: Indicates if set that DRAM initialization will be performed by the controller. Otherwise if not set it indicates that DRAM initialization will be performed using the built-in initialization sequence or using software through the configuration port.</p>
17	RW	0x0	<p>DLLBYP DLL Bypass: A setting of 1 on this bit will put all PHY DLLs in bypass mode. A bypassed DLL is also powered down (disabled).</p>

Bit	Attr	Reset Value	Description
16	RW	0x0	<p>ICPC</p> <p>Initialization Complete Pin Configuration: Specifies how the DFI 2.1 initialization complete output pin should be used to indicate the status of initialization. Valid value are:</p> <p>0 = Asserted after PHY initialization (DLL locking and impedance calibration) is complete.</p> <p>1 = Asserted after PHY initialization is complete and triggered the PHYCTL initialization (DRAM initialization, data training, or initialization trigger with no selected initialization) is complete.</p>
15:9	RO	0x0	reserved
8	RW	0x0	<p>EYETRN</p> <p>Read Data Eye Training: Executes a PHYCTL training routine to maximize the read data eye. This is not implemented in this version of the PHYCTL.</p>
7	RW	0x0	<p>QSTRN</p> <p>Read DQS Training: Executes a PHYCTL training routine to determine the optimum position of the read data DQS strobe for maximum system timing margins.</p>
6	RW	0x0	<p>DRAMINIT</p> <p>DRAM Initialization: Executes the DRAM initialization sequence.</p>
5	RW	0x0	<p>DRAMRST</p> <p>DRAM Reset (DDR3 Only): Issues a reset to the DRAM (by driving the DRAM reset pin low) and wait 200us. This can be triggered in isolation or with the full DRAM initialization (DRAMINIT). For the later case, the reset is issued and 200us is waited before starting the full initialization sequence.</p>
4	RW	0x0	<p>ITMSRST</p> <p>Interface Timing Module Soft Reset: Soft resets the interface timing modules for the data and data strobes, i.e., it asserts the ITM soft reset (srstb) signal.</p>

Bit	Attr	Reset Value	Description
3	RW	0x0	ZCAL Impedance Calibrate: Performs PHY impedance calibration.
2	RW	0x0	DLLLOCK DLL Lock: Waits for the PHY DLLs to lock.
1	RW	0x0	DLLSRST DLL Soft Rest: Soft resets all PHY DLLs by driving the DLL soft reset pin.
0	RW	0x0	INIT Initialization Trigger: A write of '1' to this bit triggers the DDR system initialization, including PHY initialization, DRAM initialization, and PHY training. The exact initialization steps to be executed are specified in bits 1 to 6 of this register. A bit setting of 1 means the step will be executed as part of the initialization sequence, while a setting of 0 (initialization) is complete.

DDR_PHYCTL_PGCR

Address: Operational Base + offset (0x0008)

PHY General Configuration Register

Bit	Attr	Reset Value	Description
31	RW	0x0	LBMODE Loopback Mode: Indicates if set that the PHY/PUB is in loopback mode
30	RW	0x0	LBGDS Loopback DQS Gating: Selects the DQS gating mode that should be used when the PHY is in loopback mode, including BIST loopback mode. Valid values are: 0 = DQS gate training will be triggered on the PUB 1 = DQS gate is set manually using software
29	RW	0x0	LBDQSS Loopback DQS Shift: Selects how the read DQS is shifted during loopback to ensure that the read DQS is centered into the read data eye. Valid values are: 0 = PUB sets the read DQS delay to 0; DQS is already shifted 90 degrees by write path 1 = The read DQS shift is set manually through software

Bit	Attr	Reset Value	Description
28:25	RW	0x0	RFSHDT Refresh During Training: A non-zero value specifies that a burst of refreshes equal to the number specified in this field should be sent to the SDRAM after training each rank except the last rank.
24	RW	0x1	PDDISDX Power Down Disabled Byte: Indicates if set that the DLL and I/Os of a disabled byte should be powered down.
23:22	RW	0x2	ZCKSEL Impedance Clock Divider Select: Selects the divide ratio for the clock used by the impedance control logic relative to the clock used by the memory controller and SDRAM. Valid values are: 00 = Divide by 2 01 = Divide by 8 10 = Divide by 32 11 = Divide by 64
21:18	RW	0xf	RANKEN Rank Enable: Specifies the ranks that are enabled for data-training. Bit 0 controls rank 0, bit 1 controls rank 1, bit 2 controls rank 2, and bit 3 controls rank 3. Setting the bit to '0' enables the rank, and setting it to '1' disables the rank.
17:16	RW	0x0	IODDRM I/O DDR Mode (D3F I/O Only): Selects the DDR mode for the I/Os.
15	RW	0x0	IOLB I/O Loop-Back Select: Selects where inside the I/O the loop-back of signals happens. Valid values are: 0 = Loopback is after output buffer; output enable must be asserted 1 = Loopback is before output buffer; output enable is don't care
14	RW	0x0	CKINV CK Invert: Specifies if set that CK/CK# should be inverted. Otherwise CK/CK# toggles with normal polarity.

Bit	Attr	Reset Value	Description
13:12	RW	0x2	<p>CKDV CK Disable Value: Specifies the static value that should be driven on CK/CK# pair(s) when the pair(s) is disabled. CKDV[0] specifies the value for CK and CKDV[1] specifies the value for CK#</p>
11:9	RW	0x7	<p>CKEN CK Enable: Controls whether the CK going to the SDRAM is enabled (toggling) or disabled (static value defined by CKDV). One bit for each of the three CK pairs.</p>
8:5	RW	0x0	<p>DTOSEL Digital Test Output Select: Selects the PHY digital test output that should be driven onto PHY digital test output (phy_dto) pin: Valid values are:</p> <ul style="list-style-type: none"> 0000 = DATX8 0 DLL digital test output 0001 = DATX8 1 DLL digital test output 0010 = DATX8 2 DLL digital test output 0011 = DATX8 3 DLL digital test output 0100 = DATX8 4 DLL digital test output 0101 = DATX8 5 DLL digital test output 0110 = DATX8 6 DLL digital test output 0111 = DATX8 7 DLL digital test output 1000 = DATX8 8 DLL digital test output 1001 = AC DLL digital test output 1010 - 01111 = Reserved
4:3	RW	0x0	<p>DFTLMT DQS Drift Limit: Specifies the expected limit of drift on read data strobes. A drift of this value or greater is reported as a drift error through the host port error flag. Valid values are:</p> <ul style="list-style-type: none"> 00 = No limit (no error reported) 01 = 90 deg drift 10 = 180 deg drift 11 = 270 deg or more drift <p>Note: Although reported through the error flag, this is not an error requiring any action. It is simply an indicator that the drift is greater than expected.</p>

Bit	Attr	Reset Value	Description
2	RW	0x1	<p>DFTCMP</p> <p>DQS Drift Compensation: Enables or disables DQS drift compensation. Valid values are:</p> <p>0 = Disables data strobe drift compensation 1 = Enables data strobe drift compensation</p> <p>By default, drift compensation is enabled.</p> <p>Note: Drift compensation must be disabled for LPDDR2.</p>
1	RW	0x0	<p>DQSCFG</p> <p>DQS Gating Configuration: Selects one of the two DQS gating schemes:</p> <p>0 = DQS gating is shut off using the rising edge of DQS_b (active windowing mode) 1 = DQS gating blankets the whole burst (passive windowing mode).</p> <p>Note: Passive windowing must be used for LPDDR2.</p>
0	RW	0x0	<p>ITMDMD</p> <p>ITM DDR Mode: Selects whether ITMS uses DQS and DQS# or it only uses DQS.</p> <p>Valid values are:</p> <p>0 = ITMS uses DQS and DQS# 1 = ITMS uses DQS only</p> <p>Note: The only valid value for DDR is 1.</p>

DDR_PHYCTL_PGSR

Address: Operational Base + offset (0x000c)

PHY General Status Register

Bit	Attr	Reset Value	Description
31	RO	0x0	<p>TQ</p> <p>Temperature Output (LPDDR Only): Connected to the DRAM TQ pin which is defined to go high when the LPDDR device temperature equals to or exceeds 85C, otherwise it is low.</p>
30:8	RO	0x0	reserved
7	RO	0x0	<p>DFTERR</p> <p>DQS Drift Error: If set, indicates that at least one of the read data strobes has drifted by more than or equal to the drift limit set in the PHY General Configuration Register (PGCR).</p>

Bit	Attr	Reset Value	Description
6	RO	0x0	DTIERR Data Training Intermittent Error: If set, indicates that there was an intermittent error during data training, such as a pass was followed by a fail then followed by another pass.
5	RO	0x0	DTERR Data Training Error: If set, indicates that a valid DQS gating window could not be found during data training.
4	RO	0x0	DTDONE Data Training Done: Indicates, if set, that the PHY has finished doing data training.
3	RO	0x0	DIDONE DRAM Initialization Done: Indicates if set that DRAM initialization has completed.
2	RO	0x0	ZCDONE Impedance Calibration Done: Indicates if set that impedance calibration has completed.
1	RO	0x0	DLDONE DLL Lock Done: Indicates if set that DLL locking has completed.
0	RO	0x0	IDONE Initialization Done: Indicates if set that the DDR system initialization has completed. This bit is set after all the selected initialization routines in PIR register have completed.

DDR_PHYCTL_DLLGCR

Address: Operational Base + offset (0x0010)

DLL General Control Register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	reserved
29	RW	0x0	LOCKDET Master lock detector enable.
28	RO	0x0	reserved
27:20	RW	0x37	SBIAS Slave Bias Trim: Used to trim the bias for the slave DLL.
19:12	RW	0x37	MBIAS Master Bias Trim: Used to trim the bias for the master DLL.

Bit	Attr	Reset Value	Description
11	RW	0x0	TESTSW Test Switch: Selects the test signals of either the master DLL ('0') or the slave DLL ('1').
10:9	RW	0x0	ATC Analog Test Control: Selects the analog signal to be output on the DLL analog test output (test_out_a) when TESTEN is high (Output is Vss when TESTEN is low). The test output either comes from the master DLL or the slave DLL, depending on the setting of the test switch (TESTSW). Both master DLL and slave DLL output similar analog test signals. Valid settings for analog test control are: 00 = Filter output (Vc) 01 = Replica bias output for NMOS (Vbn) 10 = Replica bias output for PMOS (Vbp) 11 = Vdd 00

Bit	Attr	Reset Value	Description
8:6	RW	0x0	<p>DTC Digital Test Control: Selects the digital signal to be output on the DLL digital test output (test_out_d[1]) when TESTEN is high (Output is '0' when TESTEN is low).</p> <p>Valid settings for master DLL (such as, when TESTSW = '0'):</p> <ul style="list-style-type: none"> 000 = 0 output clock (clk_0) 001 = 90 output clock (clk_90) 010 = 180 output clock (clk_180) 011 = 270 output clock (clk_270) 100 = 360 internal clock (clk_360_int) 101 = Speed-up pulse (spdup) 110 = Slow-down pulse (slwdn) 111 = 0 MCTL logic clock (cclk_0) <p>Valid settings for slave DLL (such as when TESTSW = '1'):</p> <ul style="list-style-type: none"> 000 = Input DQS strobe (dqs) 001 = Input clock reference (clk_90_in) 010 = Internal feedback clock (clk_0_out) 011 = 90 output DQS_b strobe (dqsb_90) 100 = 90 output DQS strobe (dqs_90) 101 = Speed-up pulse (spdup) 110 = Slow-down pulse (slwdn) 111 = Auto-lock enable signal
5	RW	0x0	<p>TESTEN Test Enable: Enables digital and analog test outputs selected by DTC and ATC respectively.</p>
4:2	RW	0x0	<p>IPUMP Charge Pump Current Trim: Used to trim charge pump current:</p> <ul style="list-style-type: none"> 000 = maximum current 111 = minimum current
1:0	RW	0x0	<p>DRES Delta Resistor Trim: Used to trim reference current versus resistor value variation:</p> <ul style="list-style-type: none"> 00 = Rnom 01 = Rnom - 20% 1x = Rnom + 20%

DDR_PHYCTL_AC DLLCR

Address: Operational Base + offset (0x0014)

AC DLL Control Register

Bit	Attr	Reset Value	Description
31	RW	0x0	DLLDIS DLL Disable: A disabled DLL is bypassed. Default ('0') is DLL enabled.
30	RW	0x1	DLLSRST DLL Soft Rest: Soft resets the AC DLL by driving the DLL soft reset pin.
29:20	RO	0x0	reserved
19	RW	0x0	SDLBMODE Slave DLL Loopback Mode: If this bit is set, the slave DLL is put in loopback mode in which there is no 90 degrees phase shift on read DQS/DQS#. This bit must be set when operating the byte PHYs in loopback mode such as during BIST loopback.
18	RW	0x0	ATESTEN Analog Test Enable: Enables the analog test signal to be output on the DLL analog test output (test_out_a). The DLL analog test output is tri-stated when this bit is '0'.
17:14	RW	0x0	SDPHASE Slave DLL Phase Trim: Selects the phase difference between the input clock and the corresponding output clock of the slave DLL. Valid settings: 0000 = 90 0001 = 72 0010 = 54 0011 = 36 0100 = 108 0101 = 90 0110 = 72 0111 = 54 1000 = 126 1001 = 108 1010 = 90 1011 = 72 1100 = 144 1101 = 126 1110 = 108 1111 = 90

Bit	Attr	Reset Value	Description
13:12	RW	0x0	SSTART Slave Auto Start-Up: Used to control how the slave DLL starts up relative to the master DLL locking: 0X = Slave DLL automatically starts up once the master DLL has achieved lock. 10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled. 11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.
11:9	RW	0x0	MFWDLY Master Feed-Forward Delay Trim: Used to trim the delay in the master DLL feed-forward path: 000 = minimum delay 111 = maximum delay
8:6	RW	0x0	MFBDLY Master Feed-Back Delay Trim: Used to trim the delay in the master DLL feedback path: 000 = minimum delay 111 = maximum delay
5:3	RW	0x0	SFWDLY Slave Feed-Forward Delay Trim: Used to trim the delay in the slave DLL feed-forward path: 000 = minimum delay 111 = maximum delay
2:0	RW	0x0	SFBDLY Slave Feed-Back Delay Trim: Used to trim the delay in the slave DLL feedback path: 000 = minimum delay 111 = maximum delay

DDR_PHYCTL_PTR0

Address: Operational Base + offset (0x0018)

PHY Timing Register 0

Bit	Attr	Reset Value	Description
31:22	RO	0x0	reserved

Bit	Attr	Reset Value	Description
21:18	RW	0x8	tITMSRST ITM Soft Reset Time: Number of controller clock cycles that the ITM soft reset pin must remain asserted when the soft reset is applied to the ITMs. This must correspond to a value that is equal to or more than 8 controller clock cycles. Default value corresponds to 8 controller clock cycles.
17:6	RW	0xabe	tDLLLOCK DLL Lock Time: Number of clock cycles for the DLL to stabilize and lock, i.e. number of clock cycles from when the DLL reset pin is de-asserted to when the DLL has locked and is ready for use. Refer to the PHY databook for the DLL lock time. Default value corresponds to 5.12us at 533MHz.
5:0	RW	0x1b	tDLLSRST DLL Soft Reset Time: Number of controller clock cycles that the DLL soft reset pin must remain asserted when the soft reset is triggered through the PHY Initialization Register (PIR). This must correspond to a value that is equal to or more than 50ns or 8 controller clock cycles, whichever is bigger. Default value corresponds to 50ns at 533MHz.

DDR_PHYCTL_PTR1

Address: Operational Base + offset (0x001c)

PHY Timing Register 1

Bit	Attr	Reset Value	Description
31:27	RO	0x0	reserved

Bit	Attr	Reset Value	Description
26:19	RW	0xc0	tDINIT1 DRAM Initialization Time 1: DRAM initialization time corresponding to the following: DDR3 = CKE high time to first command (tRFC +10 ns or 5 tCK, whichever value is larger) DDR2 = CKE high time to first command (400 ns) DDR = CKE high time to first command (400 ns or 1 tCK) LPDDR2 = CKE low time with power and clock stable (100 ns) Default value corresponds to DDR3 360ns at 533MHz.
18:0	RW	0x4111d	tDINIT0 DRAM Initialization Time 0: DRAM initialization time corresponding to the following: DDR3 = CKE low time with power and clock stable (500 us) DDR2 = CKE low time with power and clock stable (200 us) DDR = CKE low time with power and clock stable (200 us) LPDDR = CKE high time to first command (200 us) LPDDR2 = CKE high time to first command (200 us) Default value corresponds to DDR3 500 us at 533MHz.

DDR_PHYCTL_PTR2

Address: Operational Base + offset (0x0020)

PHY Timing Register 2

Bit	Attr	Reset Value	Description
31:27	RO	0x0	reserved

Bit	Attr	Reset Value	Description
26:17	RW	0x216	tDINIT3 DRAM Initialization Time 3: DRAM initialization time corresponding to the following: LPDDR2 = Time from ZQ initialization command to first command (1 us) Default value corresponds to the LPDDR2 1 us at 533MHz.
16:0	RW	0x1a072	tDINIT2 DRAM Initialization Time 2: DRAM initialization time corresponding to the following: DDR3 = Reset low time (200 us on power-up or 100 ns after power-up) LPDDR2 = Time from reset command to end of auto initialization (1 us + 10 us = 11 us) Default value corresponds to DDR3 200 us at 533MHz.

DDR_PHYCTL_ACIOCR

Address: Operational Base + offset (0x0024)

AC I/O Configuration Register

Bit	Attr	Reset Value	Description
31:30	RW	0x0	ACSR Address/Command Slew Rate (D3F I/O Only): Selects slew rate of the I/O for all address and command pins, as well as the optional DIMM PAR_IN pin and LPDDR TPD pin.
29	RW	0x1	RSTIOM SDRAM Reset I/O Mode: Selects SSTL mode (when set to 0) or CMOS mode (when set to 1) of the I/O for SDRAM Reset.
28	RW	0x1	RSTPDR SDRAM Reset Power Down Receiver: Powers down, when set, the input receiver on the I/O for SDRAM RST# pin.
27	RW	0x0	RSTPDD SDRAM Reset Power Down Driver: Powers down, when set, the output driver on the I/O for SDRAM RST# pin.

Bit	Attr	Reset Value	Description
26	RW	0x0	RSTODT SDRAM Reset On-Die Termination: Enables, when set, the on-die termination on the I/O for SDRAM RST# pin.
25:22	RW	0xf	RANKPDR Rank Power Down Receiver: Powers down, when set, the input receiver on the I/O CKE[3:0], ODT[3:0], and CS#[3:0] pins. RANKPDR[0] controls the power down for CKE[0], ODT[0], and CS#[0], RANKPDR[1] controls the power down for CKE[1], ODT[1], and CS#[1], and so on.
21:18	RW	0x0	CSPDD CS# Power Down Driver: Powers down, when set, the output driver on the I/O for CS#[3:0] pins. PDD[0] controls the power down for CS#[0], PDD[1] controls the power down for CS#[1], and so on. CKE and ODT driver power down is controlled by DSGCR register.
17:14	RW	0x0	RANKODT Rank On-Die Termination: Enables, when set, the on-die termination on the I/O for CKE[3:0], ODT[3:0], and CS#[3:0] pins. RANKODT[0] controls the on-die termination for CKE[0], ODT[0], and CS#[0], RANKODT[1] controls the on-die termination for CKE[1], ODT[1], and CS#[1], and so on.
13:11	RW	0x7	CKPDR CK Power Down Receiver: Powers down, when set, the input receiver on the I/O for CK[0], CK[1], and CK[2] pins, respectively
10:8	RW	0x0	CKPDD CK Power Down Driver: Powers down, when set, the output driver on the I/O for CK[0], CK[1], and CK[2] pins, respectively.
7:5	RW	0x0	CKODT CK On-Die Termination: Enables, when set, the on-die termination on the I/O for CK[0], CK[1], and CK[2] pins, respectively

Bit	Attr	Reset Value	Description
4	RW	0x1	ACPDR AC Power Down Receiver: Powers down, when set, the input receiver on the I/O for RAS#, CAS#, WE#, BA[2:0], and A[15:0] pins, as well as the optional DIMM PAR_IN pin and LPDDR TPD pin.
3	RW	0x0	ACPDD AC Power Down Driver: Powers down, when set, the output driver on the I/O for RAS#, CAS#, WE#, BA[2:0], and A[15:0] pins, as well as the optional DIMM PAR_IN pin and LPDDR TPD pin.
2	RW	0x0	ACODT Address/Command On-Die Termination: Enables, when set, the on-die termination on the I/O for RAS#, CAS#, WE#, BA[2:0], and A[15:0] pins, as well as the optional DIMM PAR_IN pin and LPDDR TPD pin.
1	RW	0x1	ACOE Address/Command Output Enable: Enables, when set, the output driver on the I/O for all address and command pins, as well as the optional DIMM PAR_IN pin and LPDDR TPD pin.
0	RW	0x0	ACIOM Address/Command I/O Mode: Selects SSTL mode (when set to 0) or CMOS mode (when set to 1) of the I/O for all address and command pins, as well as the optional DIMM PAR_IN pin and LPDDR TPD pin.

DDR_PHYCTL_DXCCR

Address: Operational Base + offset (0x0028)

DATX8 Common Configuration Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13:12	RW	0x0	DXSR Data Slew Rate (D3F I/O Only): Selects slew rate of the I/O for DQ, DM, and DQS/DQS# pins of all DATX8 macros.

Bit	Attr	Reset Value	Description
11:8	RW	0x8	DQSNRES DQS# Resistor: Selects the on-die pull-up/pull-down resistor for DQS# pins. Same encoding as DQSRES. Note: DQS# resistor must be connected for LPDDR2
7:4	RW	0x0	DQSRES DQS Resistor: Selects the on-die pull-down/pull-up resistor for DQS pins. DQSRES[3] selects pull-down (when set to 0) or pull-up (when set to 1). DQSRES[2:0] selects the resistor value as follows: 000 = Open: On-die resistor disconnected 001 = 688 ohms 010 = 611 ohms 011 = 550 ohms 100 = 500 ohms 101 = 458 ohms 110 = 393 ohms 111 = 344 ohms Note: DQS resistor must be connected for LPDDR2
3	RW	0x0	DXPDR Data Power Down Receiver: Powers down, when set, the input receiver on I/O for DQ, DM, and DQS/DQS# pins of all DATX8 macros. This bit is ORed with the PDR configuration bit of the individual DATX8.
2	RW	0x0	DXPDD Data Power Down Driver: Powers down, when set, the output driver on I/O for DQ, DM, and DQS/DQS# pins of all DATX8 macros. This bit is ORed with the PDD configuration bit of the individual DATX8.
1	RW	0x0	DXIOM Data I/O Mode: Selects SSTL mode (when set to 0) or CMOS mode (when set to 1) of the I/O for DQ, DM, and DQS/DQS# pins of all DATX8 macros. This bit is ORed with the IOM configuration bit of the individual DATX8.

Bit	Attr	Reset Value	Description
0	RW	0x0	DXODT Data On-Die Termination: Enables, when set, the on-die termination on the I/O for DQ, DM, and DQS/DQS# pins of all DATX8 macros. This bit is ORed with the ODT configuration bit of the individual DATX8.

DDR_PHYCTL_DSGCR

Address: Operational Base + offset (0x002c)

DDR System General Configuration Register

Bit	Attr	Reset Value	Description
31	RW	0x1	CKEOE SDRAM CKE Output Enable: Enables, when set, the output driver on the I/O for SDRAM CKE pins.
30	RW	0x1	RSTOE SDRAM Reset Output Enable: Enables, when set, the output driver on the I/O for SDRAM RST# pin.
29	RW	0x1	ODTOE SDRAM ODT Output Enable: Enables, when set, the output driver on the I/O for SDRAM ODT pins.
28	RW	0x1	CKOE SDRAM CK Output Enable: Enables, when set, the output driver on the I/O for SDRAM CK/CK# pins.
27	RW	0x1	TPDOE SDRAM TPD Output Enable (LPDDR Only): Enables, when set, the output driver on the I/O for SDRAM TPD pin.
26	RW	0x0	TPDPPD DRAM TPD Power Down Driver (LPDDR Only): Powers down, when set, the output driver on the I/O for SDRAM TPD pin. Note that the power down of the receiver on the I/O for SDRAM TPD pin is controlled by ACIOCR[ACPDR] register bit.

Bit	Attr	Reset Value	Description
25	RW	0x1	NL2OE Non-LPDDR2 Output Enable: Enables, when set, the output driver on the I/O for non-LPDDR2 (ODT, RAS#, CAS#, WE#, and BA) pins. This may be used when a chip that is designed for both LPDDR2 and other DDR modes is being used in LPDDR2 mode. For these pins, the I/O output enable signal (OE) is an AND of this bit and the respective output enable bit in ACIOCR or DSGCR registers.
24	RW	0x0	NL2PD Non-LPDDR2 Power Down: Powers down, when set, the output driver and the input receiver on the I/O for non-LPDDR2 (ODT, RAS#, CAS#, WE#, and BA) pins. This may be used when a chip that is designed for both LPDDR2 and other DDR modes is being used in LPDDR2 mode. For these pins, the I/O power down signal (PDD or PDR) is an OR of this bit and the respective power-down bit in ACIOCR register.
23:20	RW	0x0	ODTPDD ODT Power Down Driver: Powers down, when set, the output driver on the I/O for ODT[3:0] pins. ODTPDD[0] controls the power down for ODT[0], ODTPDD[1] controls the power down for ODT[1], and so on.
19:16	RW	0x0	CKEPDD CKE Power Down Driver: Powers down, when set, the output driver on the I/O for CKE[3:0] pins. CKEPDD[0] controls the power down for CKE[0], CKEPDD[1] controls the power down for CKE[1], and so on.
15:11	RO	0x0	reserved

Bit	Attr	Reset Value	Description
10:8	RW	0x0	DQSGE DQS Gate Early: Specifies the number of clock cycles for which the DQS gating must be enabled earlier than its normal position. Only applicable when using PDQSR I/O cell, passive DQS gating and no drift compensation. This field is recommended to be set to zero for all DDR types other than LPDDR2. For LPDDR2 it should be set to $(t_{DQSCKmax} - t_{DQSCK})$ divide by clock period and rounded up.
7:5	RW	0x0	DQSGX DQS Gate Extension: Specifies the number of clock cycles for which the DQS gating must be extended beyond the normal burst length width. Only applicable when using PDQSR I/O cell, passive DQS gating and no drift compensation. This field is recommended to be set to zero for all DDR types other than LPDDR2. For LPDDR2 it should be set to $(t_{DQSCKmax} - t_{DQSCK})$ divide by clock period and rounded up.
4	RW	0x1	LPDLLPD Low Power DLL Power Down: Specifies if set that the PHY should respond to the DFI low power opportunity request and power down the DLL of the byte if the wakeup time request satisfies the DLL lock time.
3	RW	0x1	LPIOPD Low Power I/O Power Down: Specifies if set that the PHY should respond to the DFI low power opportunity request and power down the I/Os of the byte.
2	RW	0x1	ZUEN Impedance Update Enable: Specifies if set that the PHY should perform impedance calibration (update) whenever there is a controller initiated DFI update request. Otherwise the PHY will ignore an update request from the controller.

Bit	Attr	Reset Value	Description
1	RW	0x1	BDISEN Byte Disable Enable: Specifies if set that the PHY should respond to DFI byte disable request. Otherwise the byte disable from the DFI is ignored in which case bytes can only be disabled using the DXnGCR register.
0	RW	0x1	PUREN PHY Update Request Enable: Specifies if set, that the PHY should issue PHY-initiated DFI update request when there is DQS drift of more than 3/4 of a clock cycle within one continuous (back-to-back) read burst. By default the PHY issues PHY-initiated update requests and the controller should respond otherwise the PHY may return erroneous values. The option to disable it is provided only for silicon evaluation and testing

DDR_PHYCTL_DCR

Address: Operational Base + offset (0x0030)

DRAM Configuration Register

Bit	Attr	Reset Value	Description
31	RW	0x0	TPD Test Power Down (LPDDR Only): If set will place the DRAM in deep power down mode.
30	RW	0x0	RDIMM Registered DIMM: Indicates if set that a registered DIMM is used. In this case, the PUB increases the SDRAM write and read latencies (WL/RL) by 1. This only applies to PUB internal SDRAM transactions. Transactions generated by the controller must make its own adjustments to WL/RL when using a registered DIMM.

Bit	Attr	Reset Value	Description
29	RW	0x0	UDIMM Un-buffered DIMM Address Mirroring: Indicates if set that there is address mirroring on the second rank of an un-buffered DIMM (the rank connected to CS#[1]). In this case, the PUB re-scrambles the bank and address when sending mode register commands to the second rank. This only applies to PUB internal SDRAM transactions. Transactions generated by the controller must make its own adjustments when using an un-buffered DIMM. DCR[NOSRA] must be set if address mirroring is enabled.
28	RW	0x0	DDR2T DDR 2T Timing: Indicates if set that 2T timing should be used by PUB internally generated SDRAM transactions.
27	RW	0x0	NOSRA No Simultaneous Rank Access: Specifies if set that simultaneous rank access on the same clock cycle is not allowed. This means that multiple chip select signals should not be asserted at the same time. This may be required on some DIMM systems.
26:10	RO	0x0	reserved
9:8	RW	0x0	DDRTYPE DDR Type: Selects the DDR type for the specified DDR mode. Valid values for LPDDR2 are: 00 = LPDDR2-S4 01 = LPDDR2-S2 10 = LPDDR2-NVM 11 = Reserved
7	RW	0x0	MPRDQ Multi-Purpose Register (MPR) DQ (DDR3 Only): Specifies the value that is driven on non-primary DQ pins during MPR reads. Valid values are: 0 = Primary DQ drives out the data from MPR (0-1-0-1); non-primary DQs drive '0' 1 = Primary DQ and non-primary DQs all drive the same data from MPR (0-1-0-1)

Bit	Attr	Reset Value	Description
6:4	RW	0x0	<p>PDQ Primary DQ (DDR3 Only): Specifies the DQ pin in a byte that is designated as a primary pin for Multi-Purpose Register (MPR) reads. Valid values are 0 to 7 for DQ[0] to DQ[7], respectively.</p>
3	RW	0x1	<p>DDR8BNK DDR 8-Bank: Indicates if set that the SDRAM used has 8 banks. tRPA = tRP+1 and tFAW are used for 8-bank DRAMs, other tRPA = tRP and no tFAW is used. Note that a setting of 1 for DRAMs that have fewer than 8 banks still results in correct functionality but less tighter DRAM command spacing for the parameters described here.</p>
2:0	RW	0x3	<p>DDRMD DDR Mode: SDRAM DDR mode. Valid values are: 000 = LPDDR (Mobile DDR) 001 = DDR 010 = DDR2 011 = DDR3 100 = LPDDR2 (Mobile DDR2) 101 = Reserved</p>

DDR_PHYCTL_DTPRO

Address: Operational Base + offset (0x0034)

DRAM Timing Parameters Register 0

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>tCCD Read to read and write to write command delay. Valid values are: 0 = BL/2 for DDR2 and 4 for DDR3 1 = BL/2 + 1 for DDR2 and 5 for DDR3</p>
30:25	RW	0x18	<p>tRC Activate to activate command delay (same bank). Valid values are 2 to 42.</p>
24:21	RW	0x4	<p>tRRD Activate to activate command delay (different banks). Valid values are 1 to 8.</p>
20:16	RW	0x12	<p>tRAS Activate to precharge command delay. Valid values are 2 to 31.</p>

Bit	Attr	Reset Value	Description
15:12	RW	0x6	tRCD Activate to read or write delay. Minimum time from when an activate command is issued to when a read or write to the activated row can be issued. Valid values are 2 to 11.
11:8	RW	0x6	tRP Precharge command period: The minimum time between a precharge command and any other command. Note that the Controller automatically derives tRPA for 8-bank DDR2 devices by adding 1 to tRP . Valid values are 2 to 11.
7:5	RW	0x3	tWTR Internal write to read command delay. Valid values are 1 to 6.
4:2	RW	0x3	tRTP Internal read to precharge command delay. Valid values are 2 to 6. Note that even though RTP does not apply to JEDEC DDR devices, this parameter must still be set to a minimum value of 2 for DDR because the Controller always uses the DDR2 equation, $AL + BL/2 + \max(RTP,2) - 2$, to compute the read to precharge timing (which is $BL/2$ for JEDEC DDR).
1:0	RW	0x2	tMRD Load mode cycle time: The minimum time between a load mode register command and any other command. For DDR3 this is the minimum time between two load mode register commands. Valid values for DDR2 are 2 to 3. For DDR3, the value used for tMRD is 4 plus the value programmed in these bits, i.e. tMRD value for DDR3 ranges from 4 to 7.

DDR_PHYCTL_DTPR1

Address: Operational Base + offset (0x0038)
 DRAM Timing Parameters Register 1

Bit	Attr	Reset Value	Description
31:30	RO	0x0	reserved

Bit	Attr	Reset Value	Description
29:27	RW	0x1	tDQSCKmax Maximum DQS output access time from CK/CK# (LPDDR2 only). This value is used for implementing read-to-write spacing. Valid values are 1 to 7.
26:24	RW	0x1	tDQSCK DQS output access time from CK/CK# (LPDDR2 only). This value is used for computing the read latency. Valid values are 1 to 7.. This value is derived from the corresponding parameter in the SDRAM datasheet divided by the clock cycle time without rounding up. The fractional remainder is automatically adjusted for by data training in quarter clock cycle units. If data training is not performed then this fractional remainder must be converted to quarter clock cycle units and the gating registers (DXnDQSTR) adjusted accordingly.
23:16	RW	0x83	tRFC Refresh-to-Refresh: Indicates the minimum time, in clock cycles, between two refresh commands or between a refresh and an active command. This is derived from the minimum refresh interval from the datasheet, tRFC(min), divided by the clock cycle time. The default number of clock cycles is for the largest JEDEC tRFC(min) parameter value supported.
15:12	RO	0x0	reserved
11	RW	0x0	tRTODT Read to ODT delay (DDR3 only). Specifies whether ODT can be enabled immediately after the read post-amble or one clock delay has to be added. Valid values are: 0 = ODT may be turned on immediately after read post-amble 1 = ODT may not be turned on until one clock after the read post-amble If tRTODT is set to 1, then the read-to-write latency is increased by 1 if ODT is enabled.

Bit	Attr	Reset Value	Description
10:9	RW	0x0	tMOD Load mode update delay (DDR3 only). The minimum time between a load mode register command and a non-load mode register command. Valid values are: 00 = 12 01 = 13 10 = 14 11 = 15
8:3	RW	0x12	tFAW 4-bank activate period. No more than 4-bank activate commands may be issued in a given tFAW period. Only applies to 8-bank devices. Valid values are 2 to 31.
2	RW	0x0	tRTW Read to Write command delay. Valid values are: 0 = standard bus turn around delay 1 = add 1 clock to standard bus turn around delay This parameter allows the user to increase the delay between issuing Write commands to the SDRAM when preceded by Read commands. This provides an option to increase bus turn-around margin for high frequency systems.
1:0	RW	0x0	tAOND_tAOFD ODT turn-on/turn-off delays (DDR2 only). The delays are in clock cycles. Valid values are: 00 = 2/2.5 01 = 3/3.5 10 = 4/4.5 11 = 5/5.5 Most DDR2 devices utilize a fixed value of 2/2.5. For non-standard SDRAMs, the user must ensure that the operational Write Latency is always greater than or equal to the ODT turn-on delay. For example, a DDR2 SDRAM with CAS latency set to 3 and CAS additive latency set to 0 has a Write Latency of 2. Thus 2/2.5 can be used, but not 3/3.5 or higher.

DDR_PHYCTL_DTPR2

Address: Operational Base + offset (0x003c)
 DRAM Timing Parameters Register 2

Bit	Attr	Reset Value	Description
31:29	RO	0x0	reserved
28:19	RW	0x200	tDLLK DLL locking time. Valid values are 2 to 1023.
18:15	RW	0x3	tCKE CKE minimum pulse width. Also specifies the minimum time that the SDRAM must remain in power down or self refresh mode. For DDR3 this parameter must be set to the value of tCKESR which is usually bigger than the value of tCKE. Valid values are 2 to 15.
14:10	RW	0x08	tXP Power down exit delay. The minimum time between a power down exit command and any other command. This parameter must be set to the maximum of the various minimum power down exit delay parameters specified in the SDRAM datasheet, i.e. max(tXP , tXARD, tXARDS) for DDR2 and max(tXP , tXP DLL) for DDR3. Valid values are 2 to 31.
9:0	RW	0x0c8	tXS Self refresh exit delay. The minimum time between a self refresh exit command and any other command. This parameter must be set to the maximum of the various minimum self refresh exit delay parameters specified in the SDRAM datasheet, i.e. max(tXSNR, tXSRD) for DDR2 and max(tXS, tXSDLL) for DDR3. Valid values are 2 to 1023.

DDR_PHYCTL_MR0

Address: Operational Base + offset (0x0040)
 Mode Register 0

Bit	Attr	Reset Value	Description
31:13	RO	0x0	reserved

Bit	Attr	Reset Value	Description
12	RW	0x0	<p>PD</p> <p>Power-Down Control: Controls the exit time for power-down modes. Refer to SDRAM datasheet for details on power-down modes.</p> <p>Valid values are:</p> <p>0 = Slow exit (DLL off)</p> <p>1 = Fast exit (DLL on)</p>
11:9	RW	0x5	<p>WR</p> <p>Write Recovery: This is the value of the write recovery in clock cycles. It is calculated by dividing the datasheet write recovery time, tWR (ns) by the datasheet clock cycle time, tCK (ns) and rounding up a non-integer value to the next integer.</p> <p>Valid values are:</p> <p>001 = 5 010 = 6 011 = 7 100 = 8 101 = 10 110 = 12</p> <p>All other settings are reserved and should not be used.</p> <p>NOTE: tWR (ns) is the time from the first SDRAM positive clock edge after the last data-in pair of a write command, to when a precharge of the same bank can be issued.</p>
8	RW	0x0	<p>DR</p> <p>DLL Reset: Writing a '1' to this bit will reset the SDRAM DLL. This bit is self-clearing, i.e. it returns back to '0' after the DLL reset has been issued.</p>
7	RW	0x0	<p>TM</p> <p>Operating Mode: Selects either normal operating mode (0) or test mode (1). Test mode is reserved for the manufacturer and should not be used.</p>

Bit	Attr	Reset Value	Description
6:4	RW	0x5	<p>CL_1</p> <p>CAS Latency: The delay, in clock cycles, between when the SDRAM registers a read command to when data is available. Valid values are:</p> <ul style="list-style-type: none"> 0010 = 5 0100 = 6 0110 = 7 1000 = 8 1010 = 9 1100 = 10 1110 = 11 <p>All other settings are reserved and should not be used.</p>
3	RW	0x0	<p>BT</p> <p>Burst Type: Indicates whether a burst is sequential (0) or interleaved (1).</p>
2	RW	0x0	<p>CL_0</p> <p>CAS Latency: merged with bit6-4</p>
1:0	RW	0x2	<p>BL</p> <p>Burst Length: Determines the maximum number of column locations that can be accessed during a given read or write command. Valid values are:</p> <p>Valid values for DDR3 are:</p> <ul style="list-style-type: none"> 00 = 8 (Fixed) 01 = 4 or 8 (On the fly) 10 = 4 (Fixed) 11 = Reserved

DDR_PHYCTL_MR1

Address: Operational Base + offset (0x0044)

Mode Register 1

Bit	Attr	Reset Value	Description
31:13	RO	0x0	reserved
12	RW	0x0	<p>QOFF</p> <p>Output Enable/Disable: When '0' all outputs function normal; when '1' all SDRAM outputs are disabled removing output buffer current. This feature is intended to be used for IDD characterization of read current and should not be used in normal operation.</p>

Bit	Attr	Reset Value	Description
11	RW	0x0	TDQS Termination Data Strobe: When enabled ('1') TDQS provides additional termination resistance outputs that may be useful in some system configurations. Refer to the SDRAM datasheet for details.
10	RO	0x0	reserved
9	RW	0x0	RTT_2 On Die Termination: Selects the effective resistance for SDRAM on die termination. Valid values are: 000 = ODT disabled 001 = RZQ/4 010 = RZQ/2 011 = RZQ/6 100 = RZQ/12 101 = RZQ/8 All other settings are reserved and should not be used.
8	RO	0x0	reserved
7	RW	0x0	LEVEL Write Leveling Enable: Enables write-leveling when set.
6	RW	0x0	RTT_1 On Die Termination: merged with bit9.
5	RW	0x0	DIC_1 Output Driver Impedance Control: Controls the output drive strength. Valid values are: 00 = Reserved for RZQ/6 01 = RZQ7 10 = Reserved 11 = Reserved
4:3	RW	0x0	AL Posted CAS Additive Latency: Setting additive latency that allows read and write commands to be issued to the SDRAM earlier than normal (refer to SDRAM datasheet for details). Valid values are: 00 = 0 (AL disabled) 01 = CL - 1 10 = CL - 2 11 = Reserved

Bit	Attr	Reset Value	Description
2	RW	0x0	RTT_0 On Die Termination: merged with bit9.
1	RW	0x0	DIC_0 Output Driver Impedance Control: Controls the output drive strength. Merged with bit5.
0	RW	0x0	DE DLL Enable/Disable: Enable (0) or disable (1) the DLL. DLL must be enabled for normal operation.

DDR_PHYCTL_MR2

Address: Operational Base + offset (0x0048)

Mode Register 2

Bit	Attr	Reset Value	Description
31:11	RO	0x0	reserved
10:9	RW	0x0	RTTWWR Dynamic ODT: Selects RTT for dynamic ODT. Valid values are: 00 = Dynamic ODT off 01 = RZQ/4 10 = RZQ/2 11 = Reserved
8	RO	0x0	reserved
7	RW	0x0	SRT Self-Refresh Temperature Range: Selects either normal ('0') or extended ('1') operating temperature range during self-refresh.
6	RW	0x0	ASR Auto Self-Refresh: When enabled ('1'), SDRAM automatically provide self-refresh power management functions for all supported operating temperature values. Otherwise the SRT bit must be programmed to indicate the temperature range.

Bit	Attr	Reset Value	Description
5:3	RW	0x0	<p>CWL CAS Write Latency: The delay, in clock cycles, between when the SDRAM registers a write command to when write data is available. Valid values are: 000 = 5 (tCK = 2.5ns) 001 = 6 (2.5ns > tCK = 1.875ns) 010 = 7 (1.875ns > tCK = 1.5ns) 011 = 8 (1.5ns > tCK = 1.25ns) All other settings are reserved and should not be used</p>
2:0	RW	0x0	<p>PASR Partial Array Self Refresh: Specifies that data located in areas of the array beyond the specified location will be lost if self refresh is entered. Valid settings for 4 banks are: 000 = Full Array 001 = Half Array (BA[1:0] = 00 & 01) 010 = Quarter Array (BA[1:0] = 00) 011 = Not defined 100 = 3/4 Array (BA[1:0] = 01, 10, & 11) 101 = Half Array (BA[1:0] = 10 & 11) 110 = Quarter Array (BA[1:0] = 11) 111 = Not defined Valid settings for 8 banks are: 000 = Full Array 001 = Half Array (BA[2:0] = 000, 001, 010 & 011) 010 = Quarter Array (BA[2:0] = 000, 001) 011 = 1/8 Array (BA[2:0] = 000) 100 = 3/4 Array (BA[2:0] = 010, 011, 100, 101, 110 & 111) 101 = Half Array (BA[2:0] = 100, 101, 110 & 111) 110 = Quarter Array (BA[2:0] = 110 & 111) 111 = 1/8 Array (BA[2:0] 111)</p>

DDR_PHYCTL_MR3

Address: Operational Base + offset (0x004c)

Mode Register 3

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2	RW	0x0	MPR Multi-Purpose Register Enable: Enables, if set, that read data should come from the Multi-Purpose Register. Otherwise read data come from the DRAM array.
1:0	RW	0x0	MPRLOC Multi-Purpose Register (MPR) Location: Selects MPR data location: Valid value are: 00 = Predefined pattern for system calibration All other settings are reserved and should not be used.

DDR_PHYCTL_ODTCR

Address: Operational Base + offset (0x0050)

ODT Configuration Register

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23:20	RW	0x2	WRODT1 Write ODT: Specifies whether ODT should be enabled ('1') or disabled ('0') on each of the up to four ranks when a write command is sent to rank 0. WRODT0, WRODT1 specify ODT settings when a write is to rank 0, rank 1 respectively. The four bits of each field each represent a rank, the LSB being rank 0 and the MSB being rank 1. Default is to enable ODT only on rank being written to.
19:16	RW	0x1	WRODT0 Write ODT: Specifies whether ODT should be enabled ('1') or disabled ('0') on each of the up to four ranks when a write command is sent to rank 0. WRODT0, WRODT1 specify ODT settings when a write is to rank 0, rank 1 respectively. The four bits of each field each represent a rank, the LSB being rank 0 and the MSB being rank 1. Default is to enable ODT only on rank being written to.
15:8	RO	0x0	reserved

Bit	Attr	Reset Value	Description
7:4	RW	0x0	<p>RDODT1 Read ODT: Specifies whether ODT should be enabled ('1') or disabled ('0') on each of the up to four ranks when a read command is sent to rank 1. RDODT0, RDODT1 specify ODT settings when a read is to rank 0, and rank 1, respectively. The two bits of each field each represent a rank, the LSB being rank 0 and the MSB being rank 1. Default is to disable ODT during reads.</p>
3:0	RW	0x0	<p>RDODT0 Read ODT: Specifies whether ODT should be enabled ('1') or disabled ('0') on each of the up to four ranks when a read command is sent to rank 0. RDODT0, RDODT1 specify ODT settings when a read is to rank 0, and rank 1, respectively. The two bits of each field each represent a rank, the LSB being rank 0 and the MSB being rank 1. Default is to disable ODT during reads.</p>

DDR_PHYCTL_DTAR

Address: Operational Base + offset (0x0054)

Data Training Address Register

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>DTMPR Data Training Using MPR (DDR3 Only): Specifies, if set, that data-training should use the SDRAM Multi-Purpose Register (MPR) register. Otherwise data-training is performed by first writing to some locations in the SDRAM and then reading them back.</p>
30:28	RW	0x0	<p>DTBANK Data Training Bank Address: Selects the SDRAM bank address to be used during data training.</p>
27:12	RW	0x0000	<p>DTROW Data Training Row Address: Selects the SDRAM row address to be used during data training.</p>

Bit	Attr	Reset Value	Description
11:0	RW	0x000	DTCOL Data Training Column Address: Selects the SDRAM column address to be used during data training. The lower four bits of this address must always be '0000'

DDR_PHYCTL_DTDRO

Address: Operational Base + offset (0x0058)

Data Training Data Register 0

Bit	Attr	Reset Value	Description
31:24	RW	0xdd	DTBYTE3 Data Training Data: The fourth 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.
23:16	RW	0x22	DTBYTE2 Data Training Data: The third 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.
15:8	RW	0xee	DTBYTE1 Data Training Data: The second 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.
7:0	RW	0x11	DTBYTE0 Data Training Data: The first 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.

DDR_PHYCTL_DTDRI

Address: Operational Base + offset (0x005c)

Data Training Data Register 1

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:24	RW	0x77	DTBYTE7 Data Training Data: The eighth 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.
23:16	RW	0x88	DTBYTE6 Data Training Data: The seventh 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.
15:8	RW	0xbb	DTBYTE5 Data Training Data: The sixth 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.
7:0	RW	0x44	DTBYTE4 Data Training Data: The fifth 4 bytes of data used during data training. This same data byte is used for each Byte Lane. Default sequence is a walking 1 while toggling data every data cycle.

DDR_PHYCTL_DCUAR

Address: Operational Base + offset (0x00c0)

DCU Address Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11	RW	0x0	ATYPE Access Type: Specifies the type of access to be performed using this address. Valid values are: 0 = Write access 1 = Read access

Bit	Attr	Reset Value	Description
10	RW	0x0	INCA Increment Address: Specifies, if set, that the cache address specified in WADDR and SADDR should be automatically incremented after each access of the cache. The increment happens in such a way that all the slices of a selected word are first accessed before going to the next word.
9:8	RW	0x0	CSEL Cache Select: Selects the cache to be accessed. Valid values are: 00 = Command cache 01 = Expected data cache 10 = Read data cache 11 = Reserved
7:4	RW	0x0	CSADDR Cache Slice Address: Address of the cache slice to be accessed.
3:0	RW	0x0	CWADDR Cache Word Address: Address of the cache word to be accessed.

DDR_PHYCTL_DCUDR

Address: Operational Base + offset (0x00c4)

DCU Data Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	CDATA Cache Data: Data to be written to or read from a cache. This data corresponds to the cache word slice specified by the DCU Address Register.

DDR_PHYCTL_DCURR

Address: Operational Base + offset (0x00c8)

DCU Run Register

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23	RW	0x0	XCEN Expected Compare Enable: Indicates if set that read data coming back from the SDRAM should be compared with the expected data.

Bit	Attr	Reset Value	Description
22	RW	0x0	RCEN Read Capture Enable: Indicates if set that read data coming back from the SDRAM should be captured into the read data cache.
21	RW	0x0	SCOF Stop Capture On Full: Specifies if set that the capture of read data should stop when the capture cache is full.
20	RW	0x0	SONF Stop On Nth Fail: Specifies if set that the execution of commands and the capture of read data should stop when there are N read data failures. The number of failures is specified by NFAIL. Otherwise commands execute until the end of the program or until manually stopped using a STOP command.
19:12	RW	0x00	NFAIL Number of Failures: Specifies the number of failures after which the execution of commands and the capture of read data should stop if SONF bit of this register is set. Execution of commands and the capture of read data will stop after (NFAIL+1) failures if SONF is set.
11:8	RW	0x0	EADDR End Address: Cache word address where the execution of command should end.
7:4	RW	0x0	SADDR Start Address: Cache word address where the execution of commands should begin.
3:0	RW	0x0	DINST DCU Instruction: Selects the DCU command to be executed: Valid values are: 0000 = NOP: No operation 0001 = Run: Triggers the execution of commands in the command cache. 0010 = Stop: Stops the execution of commands in the command cache. 0011 = Stop Loop: Stops the execution of an infinite loop in the command cache. 0100 = Reset: Resets all DCU run time registers. 0101 - 1111 Reserved

DDR_PHYCTL_DCULR

Address: Operational Base + offset (0x00cc)

DCU Loop Register

Bit	Attr	Reset Value	Description
31:28	RW	0x0	XLEADDR Expected Data Loop End Address: The last expected data cache word address that contains valid expected data. Expected data should looped between 0 and this address.
27:18	RO	0x0	reserved
17	RW	0x0	IDA Increment DRAM Address: Indicates if set that DRAM addresses should be incremented every time a DRAM read/write command inside the loop is executed.
16	RW	0x0	LINF Loop Infinite: Indicates if set that the loop should be executed indefinitely until stopped by the STOP command. Otherwise the loop is execute LCNT times.
15:8	RW	0x00	LCNT Loop Count: The number of times that the loop should be executed if LINF is not set.
7:4	RW	0x0	LEADDR Loop End Address: Command cache word address where the loop should end.
3:0	RW	0x0	LSADDR Loop Start Address: Command cache word address where the loop should start.

DDR_PHYCTL_DCUGCR

Address: Operational Base + offset (0x00d0)

DCU General Configuration Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	RCSW Read Capture Start Word: The capture and compare of read data should start after Nth word. For example setting this value to 12 will skip the first 12 read data.

DDR_PHYCTL_DCUTPR

Address: Operational Base + offset (0x00d4)

DCU Timing Parameters Registers

Bit	Attr	Reset Value	Description
31:24	RW	0x00	tDCUT3 DCU Generic Timing Parameter 3.
23:16	RW	0x00	tDCUT2 DCU Generic Timing Parameter 2.
15:8	RW	0x00	tDCUT1 DCU Generic Timing Parameter 1.
7:0	RW	0x00	tDCUT0 DCU Generic Timing Parameter 0.

DDR_PHYCTL_DCUSR0

Address: Operational Base + offset (0x00d8)

DCU Status Register 0

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2	RO	0x0	CFULL Capture Full: Indicates if set that the capture cache is full.
1	RO	0x0	CFAIL Capture Fail: Indicates if set that at least one read data word has failed.
0	RO	0x0	RDONE Run Done: Indicates if set that the DCU has finished executing the commands in the command cache. This bit is also set to indicate that a STOP command has successfully been executed and command execution has stopped.

DDR_PHYCTL_DCUSR1

Address: Operational Base + offset (0x00dc)

DCU Status Register 1

Bit	Attr	Reset Value	Description
31:24	RO	0x00	LPCNT Loop Count: Indicates the value of the loop count. This is useful when the program has stopped because of failures to assess how many reads were executed before first fail.
23:16	RO	0x00	FLCND Fail Count: Number of read words that have failed.

Bit	Attr	Reset Value	Description
15:0	RO	0x0000	RDCNT Read Count: Number of read words returned from the SDRAM.

DDR_PHYCTL_BISTR

Address: Operational Base + offset (0x0100)

BIST Run Register

Bit	Attr	Reset Value	Description
31:26	RO	0x0	reserved
25:23	RW	0x0	BCKSEL BIST CK Select: Selects the CK to be used for capturing loopback data on the address/command lane. Valid values are: 000 = CK[0] 001 = CK[1] 010 = CK[2] 011 = Reserved 100 = CK#[0] 101 = CK#[1] 110 = CK#[2] 111 = Reserved
22:19	RW	0x0	BDXSEL BIST DATX8 Select: Select the byte lane for comparison of loopback/read data. Valid values are 0 to 8.
18:17	RW	0x0	BDPAT BIST Data Pattern: Selects the data pattern used during BIST. Valid values are: 00 = Walking 0 01 = Walking 1 10 = LFSR-based pseudo-random 11 = User programmable
16	RW	0x0	BDMEN BIST Data Mask Enable: Enables if set that the data mask BIST should be included in the BIST run, i.e. data pattern generated and loopback data compared. This is valid only for loopback mode.
15	RW	0x0	BACEN BIST AC Enable: Enables the running of BIST on the address/command lane PHY. This bit is exclusive with BDXEN, i.e. both cannot be set to '1' at the same time.

Bit	Attr	Reset Value	Description
14	RW	0x0	BDXEN BIST DATX8 Enable: Enables the running of BIST on the data byte lane PHYs. This bit is exclusive with BACEN, i.e. both cannot be set to '1' at the same time.
13	RW	0x0	BSONF BIST Stop On Nth Fail: Specifies if set that the BIST should stop when an nth data word or address/command comparison error has been encountered.
12:5	RW	0x00	NFAIL Number of Failures: Specifies the number of failures after which the execution of commands and the capture of read data should stop if BSONF bit of this register is set. Execution of commands and the capture of read data will stop after (NFAIL+1) failures if BSONF is set.
4	RW	0x0	BINF BIST Infinite Run: Specifies if set that the BIST should be run indefinitely until it is either stopped or a failure has been encountered. Otherwise BIST is run until number of BIST words specified in the BISTWCR register has been generated.
3	RW	0x0	BMODE BIST Mode: Selects the mode in which BIST is run. Valid values are: 0 = Loopback mode: Address, commands and data loop back at the PHY I/Os. 1 = DRAM mode: Address, commands and data go to DRAM for normal memory accesses.
2:0	RW	0x0	BINST BIST Instruction: Selects the BIST instruction to be executed: Valid values are: 000 = NOP: No operation 001 = Run: Triggers the running of the BIST. 010 = Stop: Stops the running of the BIST. 011 = Reset: Resets all BIST run-time registers, such as error counters. 100 - 111 Reserved

DDR_PHYCTL_BISTMSKR0

Address: Operational Base + offset (0x0104)

BIST Mask Register 0

Bit	Attr	Reset Value	Description
31:28	RW	0x0	ODTMSK Mask bit for each of the up to 4 ODT bits.
27:24	RW	0x0	CSMSK Mask bit for each of the up to 4 CS# bits.
23:20	RW	0x0	CKEMSK Mask bit for each of the up to 4 CKE bits.
19	RW	0x0	WEMSK Mask bit for the WE#.
18:16	RW	0x0	BAMSK Mask bit for each of the up to 3 bank address bits.
15:0	RW	0x0000	AMSK Mask bit for each of the up to 16 address bits.

DDR_PHYCTL_BISTMSKR1

Address: Operational Base + offset (0x0108)

BIST Mask Register 1

Bit	Attr	Reset Value	Description
31	RW	0x0	TPDMSK Mask bit for the TPD. LPDDR Only
30	RW	0x0	PARMSK Mask bit for the PAR_IN. Only for DIMM parity support.
29:20	RO	0x0	reserved
19	RW	0x0	CASMSK Mask bit for the CAS.
18	RW	0x0	RASMSK Mask bit for the RAS.
17:16	RW	0x0	DMMSK Mask bit for the data mask (DM) bit.
15:0	RW	0x0000	DQMSK Mask bit for each of the 8 data (DQ) bits.

DDR_PHYCTL_BISTWCR

Address: Operational Base + offset (0x010c)

BIST Word Count Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:0	RW	0x0020	BWCNT BIST Word Count: Indicates the number of words to generate during BIST. This must be a multiple of DRAM burst length (BL) divided by 2, e.g. for BL=8, valid values are 4, 8, 12, 16, and so on.

DDR_PHYCTL_BISTLSR

Address: Operational Base + offset (0x0110)

BIST LFSR Seed Register

Bit	Attr	Reset Value	Description
31:0	RW	0x1234abcd	SEED LFSR seed for pseudo-random BIST patterns.

DDR_PHYCTL_BISTAR0

Address: Operational Base + offset (0x0114)

BIST Address Register 0

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved
30:28	RW	0x0	BBANK BIST Bank Address: Selects the SDRAM bank address to be used during BIST.
27:12	RW	0x0000	BROW BIST Row Address: Selects the SDRAM row address to be used during BIST.
11:0	RW	0x000	BCOL BIST Column Address: Selects the SDRAM column address to be used during BIST. The lower bits of this address must be "0000" for BL16, "000" for BL8, "00" for BL4 and "0" for BL2.

DDR_PHYCTL_BISTAR1

Address: Operational Base + offset (0x0118)

BIST Address Register 1

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:4	RW	0x000	BAINC BIST Address Increment: Selects the value by which the SDRAM address is incremented for each write/read access. This value must be at the beginning of a burst boundary, i.e. the lower bits must be "0000" for BL16, "00" for BL8, "00" for BL4 and "0" for BL2.
3:2	RW	0x3	BMRANK BIST Maximum Rank: Specifies the maximum SDRAM rank to be used during BIST. The default value is set to maximum ranks minus 1. Example default shown here is for a 4-rank system
1:0	RW	0x0	BRANK BIST Rank: Selects the SDRAM rank to be used during BIST. Valid values range from 0 to maximum ranks minus 1.

DDR_PHYCTL_BISTAR2

Address: Operational Base + offset (0x011c)

BIST Address Register 2

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved
30:28	RW	0x7	BMBANK BIST Maximum Bank Address: Specifies the maximum SDRAM bank address to be used during BIST before the address increments to the next rank.
27:12	RW	0xffff	BMROW BIST Maximum Row Address: Specifies the maximum SDRAM row address to be used during BIST before the address increments to the next bank.
11:0	RW	0xffff	BMCOL BIST Maximum Column Address: Specifies the maximum SDRAM column address to be used during BIST before the address increments to the next row.

DDR_PHYCTL_BISTUDPR

Address: Operational Base + offset (0x0120)

BIST User Data Pattern Register

Bit	Attr	Reset Value	Description
31:16	RW	0xffff	BUDP1 BIST User Data Pattern 1: Data to be applied on odd DQ pins during BIST.
15:0	RW	0x0000	BUDP0 BIST User Data Pattern 0: Data to be applied on even DQ pins during BIST.

DDR_PHYCTL_BISTGSR

Address: Operational Base + offset (0x0124)

BIST General Status Register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	CASBER CAS Bit Error: Indicates the number of bit errors on CAS.
29:28	RO	0x0	RASBER RAS Bit Error: Indicates the number of bit errors on RAS.
27:24	RO	0x0	DMBER DM Bit Error: Indicates the number of bit errors on data mask (DM) bit. DMBER[1:0] are for the first DM beat, and DMBER[3:2] are for the second DM beat.
23:22	RO	0x0	TPDBER TPD Bit Error (LPDDR Only): Indicates the number of bit errors on TPD.
21:20	RO	0x0	PARBER PAR_IN Bit Error (DIMM Only): Indicates the number of bit errors on PAR_IN.
19:3	RO	0x0	reserved
2	RO	0x0	BDXERR BIST Data Error: indicates if set that there is a data comparison error in the byte lane.
1	RO	0x0	BACERR BIST Address/Command Error: indicates if set that there is a data comparison error in the address/command lane.
0	RO	0x0	BDONE BIST Done: Indicates if set that the BIST has finished executing. This bit is reset to zero when BIST is triggered.

DDR_PHYCTL_BISTWER

Address: Operational Base + offset (0x0128)

BIST Word Error Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	DXWER Byte Word Error: Indicates the number of word errors on the byte lane. An error on any bit of the data bus including the data mask bit increments the error count.
15:0	RO	0x0000	ACWER Address/Command Word Error: Indicates the number of word errors on the address/command lane. An error on any bit of the address/command bus increments the error count.

DDR_PHYCTL_BISTBER0

Address: Operational Base + offset (0x012c)

BIST Bit Error Register 0

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	ABER Address Bit Error: Each group of two bits indicate the bit error count on each of the up to 16 address bits. [1:0] is the error count for A[0], [3:2] for A[1], and so on.

DDR_PHYCTL_BISTBER1

Address: Operational Base + offset (0x0130)

BIST Bit Error Register 1

Bit	Attr	Reset Value	Description
31:24	RO	0x00	ODTBER ODT Bit Error: Each group of two bits indicates the bit error count on each of the up to 4 ODT bits. [1:0] is the error count for ODT[0], [3:2] for ODT[1], and so on.
23:16	RO	0x00	CSBER CS# Bit Error: Each group of two bits indicates the bit error count on each of the up to 4 CS# bits. [1:0] is the error count for CS#[0], [3:2] for CS#[1], and so on.

Bit	Attr	Reset Value	Description
15:8	RO	0x00	CKEBER CKE Bit Error: Each group of two bits indicates the bit error count on each of the up to 4 CKE bits. [1:0] is the error count for CKE[0], [3:2] for CKE[1], and so on.
7:6	RO	0x0	WEBER WE# Bit Error: Indicates the number of bit errors on WE#.
5:0	RO	0x00	BABER Bank Address Bit Error: Each group of two bits indicates the bit error count on each of the up to 3 bank address bits. [1:0] is the error count for BA[0], [3:2] for BA[1], and so on.

DDR_PHYCTL_BISTBER2

Address: Operational Base + offset (0x0134)

BIST Bit Error Register 2

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	DQBER Data Bit Error: The first 16 bits indicate the error count for the first data beat (i.e. the data driven out on DQ[7:0] on the rising edge of DQS). The second 16 bits indicate the error on the second data beat (i.e. the error count of the data driven out on DQ[7:0] on the falling edge of DQS). For each of the 16-bit group, the first 2 bits are for DQ[0], the second for DQ[1], and so on.

DDR_PHYCTL_BISTWCSR

Address: Operational Base + offset (0x0138)

BIST Word Count Status Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	DXWCNT Byte Word Count: Indicates the number of words received from the byte lane.
15:0	RO	0x0000	ACWCNT Address/Command Word Count: Indicates the number of words received from the address/command lane.

DDR_PHYCTL_BISTFWRO

Address: Operational Base + offset (0x013c)
BIST Fail Word Register 0

Bit	Attr	Reset Value	Description
31:29	RO	0x0	reserved
28	RO	0x0	ODTWEBS Bit status during a word error for each of the up to 4 ODT bits.
27:24	RO	0x0	CSCWEBS Bit status during a word error for each of the up to 4 CS# bits.
23:20	RO	0x0	CKEWEBS Bit status during a word error for each of the up to 4 CKE bits.
19	RO	0x0	WEWEBS Bit status during a word error for the WE#.
18:16	RO	0x0	BAWEBS Bit status during a word error for each of the up to 3 bank address bits.
15:0	RO	0x0000	AWEBS Bit status during a word error for each of the up to 16 address bits.

DDR_PHYCTL_BISTFWR1

Address: Operational Base + offset (0x0140)
BIST Fail Word Register 1

Bit	Attr	Reset Value	Description
31	RO	0x0	TPDWEBS Bit status during a word error for the TPD. LPDDR Only
30	RO	0x0	PARWEBS Bit status during a word error for the PAR_IN. Only for DIMM parity support.
29:20	RO	0x0	reserved
19	RO	0x0	CASWEBS Bit status during a word error for the CAS.
18	RO	0x0	RASWEBS Bit status during a word error for the RAS.
17:16	RO	0x0	DMWEBS Bit status during a word error for the data mask (DM) bit. DMWEBS [0] is for the first DM beat, and DMWEBS [1] is for the second DM beat.

Bit	Attr	Reset Value	Description
15:0	RO	0x0000	DQWEBS Bit status during a word error for each of the 8 data (DQ) bits. The first 8 bits indicate the status of the first data beat (i.e. the status of the data driven out on DQ[7:0] on the rising edge of DQS). The second 8 bits indicate the status of the second data beat (i.e. the status of the data driven out on DQ[7:0] on the falling edge of DQS). For each of the 8-bit group, the first bit is for DQ[0], the second bit is for DQ[1], and so on.

DDR_PHYCTL_ZQ0CRO

Address: Operational Base + offset (0x0180)

ZQ 0 Impedance Control Register 0

Bit	Attr	Reset Value	Description
31	RW	0x0	ZQPD ZQ Power Down: Powers down, if set, the PZQ cell.
30	RW	0x0	ZCAL Impedance Calibration Trigger: A write of '1' to this bit triggers impedance calibration to be performed by the impedance control logic. The impedance calibration trigger bit is self-clearing and returns back to '0' when the calibration is complete.
29	RW	0x0	ZCALBYP Impedance Calibration Bypass: Disables, if set, impedance calibration of this ZQ control block when impedance calibration is triggered globally using the ZCAL bit of PIR. Impedance calibration of this ZQ block may be triggered manually using ZCAL.
28	RW	0x0	ZDEN Impedance Over-ride Enable: When this bit is set, it allows users to directly drive the impedance control using the data programmed in the ZQDATA field. Otherwise, the control is generated automatically by the impedance control logic

Bit	Attr	Reset Value	Description
27:0	RW	0x000014a	<p>ZDATA Impedance Over-Ride Data: Data used to directly drive the impedance control.</p> <p>ZDATA field mapping for D3R I/Os is as follows:</p> <ul style="list-style-type: none"> ZDATA[27:20] is reserved and returns zeros on reads ZDATA[19:15] is used to select the pull-up on-die termination impedance ZDATA[14:10] is used to select the pull-down on-die termination impedance ZDATA[9:5] is used to select the pull-up output impedance ZDATA[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ0CR1

Address: Operational Base + offset (0x0184)

ZQ 0 Impedance Control Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x7b	<p>ZPROG Impedance Divide Ratio: Selects the external resistor divide ratio to be used to set the output impedance and the on-die termination as follows:</p> <ul style="list-style-type: none"> ZPROG[7:4] = On-die termination divide select ZPROG[3:0] = Output impedance divide select

DDR_PHYCTL_ZQ0SR0

Address: Operational Base + offset (0x0188)

ZQ 0 Impedance Status Register 0

Bit	Attr	Reset Value	Description
31	RO	0x0	<p>ZDONE Impedance Calibration Done: Indicates that impedance calibration has completed.</p>
30	RO	0x0	<p>ZERR Impedance Calibration Error: If set, indicates that there was an error during impedance calibration.</p>

Bit	Attr	Reset Value	Description
29:28	RO	0x0	reserved
27:0	RO	0x0000000	ZCTRL Impedance Control: Current value of impedance control. ZCTRL field mapping for D3R I/Os is as follows: ZCTRL[27:20] is reserved and returns zeros on reads ZCTRL[19:15] is used to select the pull-up on-die termination impedance ZCTRL[14:10] is used to select the pull-down on-die termination impedance ZCTRL[9:5] is used to select the pull-up output impedance ZCTRL[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ0SR1

Address: Operational Base + offset (0x018c)

ZQ 0 Impedance Status Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:6	RO	0x0	OPU On-die termination (ODT) pull-up calibration status. Similar status encodings as ZPD.
5:4	RO	0x0	OPD On-die termination (ODT) pull-down calibration status. Similar status encodings as ZPD.
3:2	RO	0x0	ZPU Output impedance pull-up calibration status. Similar status encodings as ZPD.
1:0	RO	0x0	ZPD Output impedance pull-down calibration status. Valid status encodings are: 00 = Completed with no errors 01 = Overflow error 10 = Underflow error 11 = Calibration in progress

DDR_PHYCTL_ZQ1CR0

Address: Operational Base + offset (0x0190)

ZQ 1 Impedance Control Register 0

Bit	Attr	Reset Value	Description
31	RW	0x0	ZQPD ZQ Power Down: Powers down, if set, the PZQ cell.
30	RW	0x0	ZCAL Impedance Calibration Trigger: A write of '1' to this bit triggers impedance calibration to be performed by the impedance control logic. The impedance calibration trigger bit is self-clearing and returns back to '0' when the calibration is complete.
29	RW	0x0	ZCALBYP Impedance Calibration Bypass: Disables, if set, impedance calibration of this ZQ control block when impedance calibration is triggered globally using the ZCAL bit of PIR. Impedance calibration of this ZQ block may be triggered manually using ZCAL.
28	RW	0x0	ZDEN Impedance Over-ride Enable: When this bit is set, it allows users to directly drive the impedance control using the data programmed in the ZQDATA field. Otherwise, the control is generated automatically by the impedance control logic
27:0	RW	0x000014a	ZDATA Impedance Over-Ride Data: Data used to directly drive the impedance control. ZDATA field mapping for D3R I/Os is as follows: ZDATA[27:20] is reserved and returns zeros on reads ZDATA[19:15] is used to select the pull-up on-die termination impedance ZDATA[14:10] is used to select the pull-down on-die termination impedance ZDATA[9:5] is used to select the pull-up output impedance ZDATA[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ1CR1

Address: Operational Base + offset (0x0194)

ZQ 1 Impedance Control Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x7b	ZPROG Impedance Divide Ratio: Selects the external resistor divide ratio to be used to set the output impedance and the on-die termination as follows: ZPROG[7:4] = On-die termination divide select ZPROG[3:0] = Output impedance divide select

DDR_PHYCTL_ZQ1SR0

Address: Operational Base + offset (0x0198)

ZQ 1 Impedance Status Register 0

Bit	Attr	Reset Value	Description
31	RO	0x0	ZDONE Impedance Calibration Done: Indicates that impedance calibration has completed.
30	RO	0x0	ZERR Impedance Calibration Error: If set, indicates that there was an error during impedance calibration.
29:28	RO	0x0	reserved
27:0	RO	0x0000000	ZCTRL Impedance Control: Current value of impedance control. ZCTRL field mapping for D3R I/Os is as follows: ZCTRL[27:20] is reserved and returns zeros on reads ZCTRL[19:15] is used to select the pull-up on-die termination impedance ZCTRL[14:10] is used to select the pull-down on-die termination impedance ZCTRL[9:5] is used to select the pull-up output impedance ZCTRL[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ1SR1

Address: Operational Base + offset (0x019c)

ZQ 1 Impedance Status Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:6	RO	0x0	OPU On-die termination (ODT) pull-up calibration status. Similar status encodings as ZPD.
5:4	RO	0x0	OPD On-die termination (ODT) pull-down calibration status. Similar status encodings as ZPD.
3:2	RO	0x0	ZPU Output impedance pull-up calibration status. Similar status encodings as ZPD.
1:0	RO	0x0	ZPD Output impedance pull-down calibration status. Valid status encodings are: 00 = Completed with no errors 01 = Overflow error 10 = Underflow error 11 = Calibration in progress

DDR_PHYCTL_ZQ2CR0

Address: Operational Base + offset (0x01a0)

ZQ 2 Impedance Control Register 0

Bit	Attr	Reset Value	Description
31	RW	0x0	ZQPD ZQ Power Down: Powers down, if set, the PZQ cell.
30	RW	0x0	ZCAL Impedance Calibration Trigger: A write of '1' to this bit triggers impedance calibration to be performed by the impedance control logic. The impedance calibration trigger bit is self-clearing and returns back to '0' when the calibration is complete.
29	RW	0x0	ZCALBYP Impedance Calibration Bypass: Disables, if set, impedance calibration of this ZQ control block when impedance calibration is triggered globally using the ZCAL bit of PIR. Impedance calibration of this ZQ block may be triggered manually using ZCAL.

Bit	Attr	Reset Value	Description
28	RW	0x0	ZDEN Impedance Over-ride Enable: When this bit is set, it allows users to directly drive the impedance control using the data programmed in the ZQDATA field. Otherwise, the control is generated automatically by the impedance control logic
27:0	RW	0x000014a	ZDATA Impedance Over-Ride Data: Data used to directly drive the impedance control. ZDATA field mapping for D3R I/Os is as follows: ZDATA[27:20] is reserved and returns zeros on reads ZDATA[19:15] is used to select the pull-up on-die termination impedance ZDATA[14:10] is used to select the pull-down on-die termination impedance ZDATA[9:5] is used to select the pull-up output impedance ZDATA[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ2CR1

Address: Operational Base + offset (0x01a4)

ZQ 2 Impedance Control Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x7b	ZPROG Impedance Divide Ratio: Selects the external resistor divide ratio to be used to set the output impedance and the on-die termination as follows: ZPROG[7:4] = On-die termination divide select ZPROG[3:0] = Output impedance divide select

DDR_PHYCTL_ZQ2SR0

Address: Operational Base + offset (0x01a8)

ZQ 2 Impedance Status Register 0

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31	RO	0x0	ZDONE Impedance Calibration Done: Indicates that impedance calibration has completed.
30	RO	0x0	ZERR Impedance Calibration Error: If set, indicates that there was an error during impedance calibration.
29:28	RO	0x0	reserved
27:0	RO	0x0000000	ZCTRL Impedance Control: Current value of impedance control. ZCTRL field mapping for D3R I/Os is as follows: ZCTRL[27:20] is reserved and returns zeros on reads ZCTRL[19:15] is used to select the pull-up on-die termination impedance ZCTRL[14:10] is used to select the pull-down on-die termination impedance ZCTRL[9:5] is used to select the pull-up output impedance ZCTRL[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ2SR1

Address: Operational Base + offset (0x01ac)

ZQ 2 Impedance Status Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:6	RO	0x0	OPU On-die termination (ODT) pull-up calibration status. Similar status encodings as ZPD.
5:4	RO	0x0	OPD On-die termination (ODT) pull-down calibration status. Similar status encodings as ZPD.
3:2	RO	0x0	ZPU Output impedance pull-up calibration status. Similar status encodings as ZPD.

Bit	Attr	Reset Value	Description
1:0	RO	0x0	ZPD Output impedance pull-down calibration status. Valid status encodings are: 00 = Completed with no errors 01 = Overflow error 10 = Underflow error 11 = Calibration in progress

DDR_PHYCTL_ZQ3CR0

Address: Operational Base + offset (0x01b0)

ZQ 3 Impedance Control Register 0

Bit	Attr	Reset Value	Description
31	RW	0x0	ZQPD ZQ Power Down: Powers down, if set, the PZQ cell.
30	RW	0x0	ZCAL Impedance Calibration Trigger: A write of '1' to this bit triggers impedance calibration to be performed by the impedance control logic. The impedance calibration trigger bit is self-clearing and returns back to '0' when the calibration is complete.
29	RW	0x0	ZCALBYP Impedance Calibration Bypass: Disables, if set, impedance calibration of this ZQ control block when impedance calibration is triggered globally using the ZCAL bit of PIR. Impedance calibration of this ZQ block may be triggered manually using ZCAL.
28	RW	0x0	ZDEN Impedance Over-ride Enable: When this bit is set, it allows users to directly drive the impedance control using the data programmed in the ZQDATA field. Otherwise, the control is generated automatically by the impedance control logic

Bit	Attr	Reset Value	Description
27:0	RW	0x000014a	<p>ZDATA Impedance Over-Ride Data: Data used to directly drive the impedance control.</p> <p>ZDATA field mapping for D3R I/Os is as follows:</p> <ul style="list-style-type: none"> ZDATA[27:20] is reserved and returns zeros on reads ZDATA[19:15] is used to select the pull-up on-die termination impedance ZDATA[14:10] is used to select the pull-down on-die termination impedance ZDATA[9:5] is used to select the pull-up output impedance ZDATA[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ3CR1

Address: Operational Base + offset (0x01b4)

ZQ 3 Impedance Control Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x7b	<p>ZPROG Impedance Divide Ratio: Selects the external resistor divide ratio to be used to set the output impedance and the on-die termination as follows:</p> <ul style="list-style-type: none"> ZPROG[7:4] = On-die termination divide select ZPROG[3:0] = Output impedance divide select

DDR_PHYCTL_ZQ3SR0

Address: Operational Base + offset (0x01b8)

ZQ 3 Impedance Status Register 0

Bit	Attr	Reset Value	Description
31	RO	0x0	<p>ZDONE Impedance Calibration Done: Indicates that impedance calibration has completed.</p>
30	RO	0x0	<p>ZERR Impedance Calibration Error: If set, indicates that there was an error during impedance calibration.</p>

Bit	Attr	Reset Value	Description
29:28	RO	0x0	reserved
27:0	RO	0x0000000	ZCTRL Impedance Control: Current value of impedance control. ZCTRL field mapping for D3R I/Os is as follows: ZCTRL[27:20] is reserved and returns zeros on reads ZCTRL[19:15] is used to select the pull-up on-die termination impedance ZCTRL[14:10] is used to select the pull-down on-die termination impedance ZCTRL[9:5] is used to select the pull-up output impedance ZCTRL[4:0] is used to select the pull-down output impedance

DDR_PHYCTL_ZQ3SR1

Address: Operational Base + offset (0x01bc)

ZQ 3 Impedance Status Register 1

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:6	RO	0x0	OPU On-die termination (ODT) pull-up calibration status. Similar status encodings as ZPD.
5:4	RO	0x0	OPD On-die termination (ODT) pull-down calibration status. Similar status encodings as ZPD.
3:2	RO	0x0	ZPU Output impedance pull-up calibration status. Similar status encodings as ZPD.
1:0	RO	0x0	ZPD Output impedance pull-down calibration status. Valid status encodings are: 00 = Completed with no errors 01 = Overflow error 10 = Underflow error 11 = Calibration in progress

DDR_PHYCTL_DX0GCR

Address: Operational Base + offset (0x01c0)

DATX8 0 General Configuration Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RW	0x0	<p>RTTOAL</p> <p>RTT On Additive Latency: Indicates when the ODT control of DQ/DQS SSTL I/Os is set to the value in DQODT/DQSODT during read cycles.</p> <p>Valid values are:</p> <p>0 = ODT control is set to DQSODT/DQODT almost two cycles before read data preamble</p> <p>1 = ODT control is set to DQSODT/DQODT almost one cycle before read data preamble</p>
12:11	RW	0x0	<p>RTTOH</p> <p>RTT Output Hold: Indicates the number of clock cycles (from 0 to 3) after the read data postamble for which ODT control should remain set to DQSODT for DQS or DQODT for DQ/DM before disabling it (setting it to '0' when using dynamic ODT control. ODT is disabled almost RTTOH clock cycles after the read postamble</p>
10	RW	0x1	<p>DQRTT</p> <p>DQ Dynamic RTT Control: Indicates, if set, that the ODT control of DQ/DM SSTL I/Os be dynamically controlled by setting it to the value in DQODT during reads and disabling it (setting it to '0' during any other cycle. If this bit is not set, then the ODT control of DQ SSTL I/Os is always set to the value in DQODT.</p>
9	RW	0x1	<p>DQSRTT</p> <p>DQS Dynamic RTT Control: Indicates, if set, that the ODT control of DQS SSTL I/Os be dynamically controlled by setting it to the value in DQSODT during reads and disabling it (setting it to 0 during any other cycle. If this bit is not set, then the ODT control of DQS SSTL I/Os is always set to the value in DQSODT field.</p>

Bit	Attr	Reset Value	Description
8:7	RW	0x1	DSEN Write DQS Enable: Controls whether the write DQS going to the SDRAM is enabled (toggling) or disabled (static value) and whether the DQS is inverted. DQS# is always the inversion of DQS. These values are valid only when DQS/DQS# output enable is on, otherwise the DQS/DQS# is tristated. Valid settings are: 00 = DQS disabled (Driven to constant 0) 01 = DQS toggling with inverted polarity 10 = DQS toggling with normal polarity (This should be the default setting) 11 = DQS disabled (Driven to constant 1)
6	RW	0x0	DQSRPD DQSR Power Down: Powers down, if set, the PDQSR cell. This bit is ORed with the common PDR configuration bit
5	RW	0x0	DXPDR Data Power Down Receiver: Powers down, when set, the input receiver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDR configuration bit
4	RW	0x0	DXPDD Data Power Down Driver: Powers down, when set, the output driver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDD configuration bit
3	RW	0x0	DXIOM Data I/O Mode: Selects SSTL mode (when set to 0) or CMOS mode (when set to 1) of the I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the IOM configuration bit of the individual DATX8
2	RW	0x0	DQODT Data On-Die Termination: Enables, when set, the on-die termination on the I/O for DQ and DM pins of the byte. This bit is ORed with the common DATX8 ODT configuration bit

Bit	Attr	Reset Value	Description
1	RW	0x0	DQSODT DQS On-Die Termination: Enables, when set, the on-die termination on the I/O for DQS/DQS# pin of the byte. This bit is ORed with the common DATX8 ODT configuration bit
0	RW	0x1	DXEN Data Byte Enable: Enables if set the DATX8 and SSTL I/Os used on the data byte. Setting this bit to '0' disables the byte, i.e. the byte SSTL I/Os are put in power-down mode and the DLL in the DATX8 is put in bypass mode.

DDR_PHYCTL_DX0GSR0

Address: Operational Base + offset (0x01c4)

DATX8 0 General Status Register 0

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved
24:13	RO	0x000	DTPASS Data Training Pass Count: The number of passing configurations during DQS gate training. Bits [2:0] are for rank 0, bits [5:3] for rank 1, and so on.
12	RO	0x0	reserved
11:8	RO	0x0	DTIERR Data Training Intermittent Error: If set, indicates that there was an intermittent error during data training of the byte, such as a pass was followed by a fail then followed by another pass. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
7:4	RO	0x0	DTERR Data Training Error: If set, indicates that a valid DQS gating window could not be found during data training of the byte. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
3:0	RO	0x0	DTDONE Data Training Done: Indicates, if set, that the byte has finished doing data training. Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX0GSR1

Address: Operational Base + offset (0x01c8)

DATX8 0 General Status Register 1

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:4	RO	0x00	DQSDFT DQS Drift: Used to report the drift on the read data strobe of the data byte. Valid settings are: 00 = No drift 01 = 90 deg drift 10 = 180 deg drift 11 = 270 deg drift or more Bits [1:0] are for rank 0, bits [3:2] for rank 1, and so on.
3:0	RO	0x0	DFTERR DQS Drift Error: If set, indicates that the byte read data strobe has drifted by more than or equal to the drift limit set in the PHY General Configuration Register (PGCR). Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX0DLLCR

Address: Operational Base + offset (0x01cc)

DATX8 0 DLL Control Register

Bit	Attr	Reset Value	Description
31	RW	0x0	DLLDIS DLL Disable: A disabled DLL is bypassed. Default ('0') is DLL enabled.
30	RW	0x1	DLLSRST DLL Soft Rest: Soft resets the byte DLL by driving the DLL soft reset pin.
29:20	RO	0x0	reserved
19	RW	0x0	SDLBMODE Slave DLL Loopback Mode: If this bit is set, the slave DLL is put in loopback mode in which there is no 90 degrees phase shift on read DQS/DQS#. This bit must be set when operating the byte PHYs in loopback mode such as during BIST loopback. Applicable only to PHYs that have this feature. Refer to PHY databook.

Bit	Attr	Reset Value	Description
18	RW	0x0	<p>ATESTEN Analog Test Enable: Enables the analog test signal to be output on the DLL analog test output (test_out_a). The DLL analog test output is tri-stated when this bit is '0'.</p>
17:14	RW	0x0	<p>SDPHASE Slave DLL Phase Trim: Selects the phase difference between the input clock and the corresponding output clock of the slave DLL. Valid settings: 0000 = 90 0001 = 72 0010 = 54 0011 = 36 0100 = 108 0101 = 90 0110 = 72 0111 = 54 1000 = 126 1001 = 108 1010 = 90 1011 = 72 1100 = 144 1101 = 126 1110 = 108 1111 = 90</p>
13:12	RW	0x0	<p>SSTART Slave Auto Start-Up: Used to control how the slave DLL starts up relative to the master DLL locking: 0X = Slave DLL automatically starts up once the master DLL has achieved lock. 10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled. 11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.</p>
11:9	RW	0x0	<p>MFWDLY Master Feed-Forward Delay Trim: Used to trim the delay in the master DLL feed-forward path: 000 = minimum delay 111 = maximum delay</p>

Bit	Attr	Reset Value	Description
8:6	RW	0x0	MFBDLY Master Feed-Back Delay Trim: Used to trim the delay in the master DLL feedback path: 000 = minimum delay 111 = maximum delay
5:3	RW	0x0	SFWDLY Slave Feed-Forward Delay Trim: Used to trim the delay in the slave DLL feed-forward path: 000 = minimum delay 111 = maximum delay
2:0	RW	0x0	SFBDLY Slave Feed-Back Delay Trim: Used to trim the delay in the slave DLL feedback path: 000 = minimum delay 111 = maximum delay

DDR_PHYCTL_DX0DQTR

Address: Operational Base + offset (0x01d0)

DATX8 0 DQ Timing Register

Bit	Attr	Reset Value	Description
31:28	RW	0xf	DQDLY7 DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are: 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
27:24	RW	0xf	<p>DQDLY6</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
23:20	RW	0xf	<p>DQDLY5</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
19:16	RW	0xf	<p>DQDLY4</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
15:12	RW	0xf	<p>DQDLY3</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
11:8	RW	0xf	<p>DQDLY2</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
7:4	RW	0xf	<p>DQDLY1</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
3:0	RW	0xf	<p>DQDLY0</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

DDR_PHYCTL_DX0DQSTR

Address: Operational Base + offset (0x01d4)

DATX8 0 DQS Timing Register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	reserved
29:26	RW	0xf	<p>DMDLY</p> <p>DM Delay: Used to adjust the delay of the data mask relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. The lower two bits of the DQMDLY controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
25:23	RW	0x3	<p>DQSNDLY</p> <p>DQS# Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are:</p> <ul style="list-style-type: none"> 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps
22:20	RW	0x3	<p>DQSDLY</p> <p>DQS Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are:</p> <ul style="list-style-type: none"> 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps

Bit	Attr	Reset Value	Description
19:18	RW	0x1	<p>R3DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
17:16	RW	0x1	<p>R2DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
15:14	RW	0x1	<p>R1DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
13:12	RW	0x1	<p>R0DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
11:9	RW	0x0	<p>R3DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
8:6	RW	0x0	<p>R2DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
5:3	RW	0x0	<p>R1DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
2:0	RW	0x0	<p>R0DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none"> 000 = No extra clock cycles 001 = 1 extra clock cycle 010 = 2 extra clock cycles 011 = 3 extra clock cycles 100 = 4 extra clock cycles 101 = 5 extra clock cycles 110 = Reserved 111 = Reserved

DDR_PHYCTL_DX1GCR

Address: Operational Base + offset (0x0200)

DATX8 1 General Configuration Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RW	0x0	<p>RTTOAL</p> <p>RTT On Additive Latency: Indicates when the ODT control of DQ/DQS SSTL I/Os is set to the value in DQODT/DQSODT during read cycles. Valid values are:</p> <ul style="list-style-type: none"> 0 = ODT control is set to DQSODT/DQODT almost two cycles before read data preamble 1 = ODT control is set to DQSODT/DQODT almost one cycle before read data preamble

Bit	Attr	Reset Value	Description
12:11	RW	0x0	RTTOH RTT Output Hold: Indicates the number of clock cycles (from 0 to 3) after the read data postamble for which ODT control should remain set to DQSODT for DQS or DQODT for DQ/DM before disabling it (setting it to '0' when using dynamic ODT control. ODT is disabled almost RTTOH clock cycles after the read postamble)
10	RW	0x1	DQRTT DQ Dynamic RTT Control: Indicates, if set, that the ODT control of DQ/DM SSTL I/Os be dynamically controlled by setting it to the value in DQODT during reads and disabling it (setting it to '0' during any other cycle. If this bit is not set, then the ODT control of DQ SSTL I/Os is always set to the value in DQODT.
9	RW	0x1	DQSRTT DQS Dynamic RTT Control: Indicates, if set, that the ODT control of DQS SSTL I/Os be dynamically controlled by setting it to the value in DQSODT during reads and disabling it (setting it to 0 during any other cycle. If this bit is not set, then the ODT control of DQS SSTL I/Os is always set to the value in DQSODT field.
8:7	RW	0x1	DSEN Write DQS Enable: Controls whether the write DQS going to the SDRAM is enabled (toggling) or disabled (static value) and whether the DQS is inverted. DQS# is always the inversion of DQS. These values are valid only when DQS/DQS# output enable is on, otherwise the DQS/DQS# is tristated. Valid settings are: 00 = DQS disabled (Driven to constant 0) 01 = DQS toggling with inverted polarity 10 = DQS toggling with normal polarity (This should be the default setting) 11 = DQS disabled (Driven to constant 1)
6	RW	0x0	DQSRPD DQSR Power Down: Powers down, if set, the PDQSR cell. This bit is ORed with the common PDR configuration bit

Bit	Attr	Reset Value	Description
5	RW	0x0	DXPDR Data Power Down Receiver: Powers down, when set, the input receiver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDR configuration bit
4	RW	0x0	DXPDD Data Power Down Driver: Powers down, when set, the output driver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDD configuration bit
3	RW	0x0	DXIOM Data I/O Mode: Selects SSTL mode (when set to 0) or CMOS mode (when set to 1) of the I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the IOM configuration bit of the individual DATX8
2	RW	0x0	DQODT Data On-Die Termination: Enables, when set, the on-die termination on the I/O for DQ and DM pins of the byte. This bit is ORed with the common DATX8 ODT configuration bit
1	RW	0x0	DQSODT DQS On-Die Termination: Enables, when set, the on-die termination on the I/O for DQS/DQS# pin of the byte. This bit is ORed with the common DATX8 ODT configuration bit
0	RW	0x1	DXEN Data Byte Enable: Enables if set the DATX8 and SSTL I/Os used on the data byte. Setting this bit to '0' disables the byte, i.e. the byte SSTL I/Os are put in power-down mode and the DLL in the DATX8 is put in bypass mode.

DDR_PHYCTL_DX1GSR0

Address: Operational Base + offset (0x0204)

DATX8 1 General Status Register 0

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved

Bit	Attr	Reset Value	Description
24:13	RO	0x000	DTPASS Data Training Pass Count: The number of passing configurations during DQS gate training. Bits [2:0] are for rank 0, bits [5:3] for rank 1, and so on.
12	RO	0x0	reserved
11:8	RO	0x0	DTIERR Data Training Intermittent Error: If set, indicates that there was an intermittent error during data training of the byte, such as a pass was followed by a fail then followed by another pass. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
7:4	RO	0x0	DTERR Data Training Error: If set, indicates that a valid DQS gating window could not be found during data training of the byte. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
3:0	RO	0x0	DTDONE Data Training Done: Indicates, if set, that the byte has finished doing data training. Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX1GSR1

Address: Operational Base + offset (0x0208)

DATX8 1 General Status Register 1

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:4	RO	0x00	DQSDFT DQS Drift: Used to report the drift on the read data strobe of the data byte. Valid settings are: 00 = No drift 01 = 90 deg drift 10 = 180 deg drift 11 = 270 deg drift or more Bits [1:0] are for rank 0, bits [3:2] for rank 1, and so on.

Bit	Attr	Reset Value	Description
3:0	RO	0x0	DFTERR DQS Drift Error: If set, indicates that the byte read data strobe has drifted by more than or equal to the drift limit set in the PHY General Configuration Register (PGCR). Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX1DLLCR

Address: Operational Base + offset (0x020c)

DATX8 1 DLL Control Register

Bit	Attr	Reset Value	Description
31	RW	0x0	DLLDIS DLL Disable: A disabled DLL is bypassed. Default ('0') is DLL enabled.
30	RW	0x1	DLLSRST DLL Soft Rest: Soft resets the byte DLL by driving the DLL soft reset pin.
29:20	RO	0x0	reserved
19	RW	0x0	SDLBMODE Slave DLL Loopback Mode: If this bit is set, the slave DLL is put in loopback mode in which there is no 90 degrees phase shift on read DQS/DQS#. This bit must be set when operating the byte PHYs in loopback mode such as during BIST loopback. Applicable only to PHYs that have this feature. Refer to PHY databook.
18	RW	0x0	ATESTEN Analog Test Enable: Enables the analog test signal to be output on the DLL analog test output (test_out_a). The DLL analog test output is tri-stated when this bit is '0'.

Bit	Attr	Reset Value	Description
17:14	RW	0x0	<p>SDPHASE Slave DLL Phase Trim: Selects the phase difference between the input clock and the corresponding output clock of the slave DLL. Valid settings:</p> <p>0000 = 90 0001 = 72 0010 = 54 0011 = 36 0100 = 108 0101 = 90 0110 = 72 0111 = 54 1000 = 126 1001 = 108 1010 = 90 1011 = 72 1100 = 144 1101 = 126 1110 = 108 1111 = 90</p>
13:12	RW	0x0	<p>SSTART Slave Auto Start-Up: Used to control how the slave DLL starts up relative to the master DLL locking:</p> <p>0X = Slave DLL automatically starts up once the master DLL has achieved lock. 10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled. 11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.</p>
11:9	RW	0x0	<p>MFWDLY Master Feed-Forward Delay Trim: Used to trim the delay in the master DLL feed-forward path:</p> <p>000 = minimum delay 111 = maximum delay</p>
8:6	RW	0x0	<p>MFBDLY Master Feed-Back Delay Trim: Used to trim the delay in the master DLL feedback path:</p> <p>000 = minimum delay 111 = maximum delay</p>

Bit	Attr	Reset Value	Description
5:3	RW	0x0	SFWDLY Slave Feed-Forward Delay Trim: Used to trim the delay in the slave DLL feed-forward path: 000 = minimum delay 111 = maximum delay
2:0	RW	0x0	SFBDLY Slave Feed-Back Delay Trim: Used to trim the delay in the slave DLL feedback path: 000 = minimum delay 111 = maximum delay

DDR_PHYCTL_DX1DQTR

Address: Operational Base + offset (0x0210)

DATX8 1 DQ Timing Register

Bit	Attr	Reset Value	Description
31:28	RW	0xf	DQDLY7 DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are: 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
27:24	RW	0xf	<p>DQDLY6</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
23:20	RW	0xf	<p>DQDLY5</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
19:16	RW	0xf	<p>DQDLY4</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
15:12	RW	0xf	<p>DQDLY3</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
11:8	RW	0xf	<p>DQDLY2</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
7:4	RW	0xf	<p>DQDLY1</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
3:0	RW	0xf	<p>DQDLY0</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

DDR_PHYCTL_DX1DQSTR

Address: Operational Base + offset (0x0214)

DATX8 1 DQS Timing Register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	reserved
29:26	RW	0xf	<p>DMDLY</p> <p>DM Delay: Used to adjust the delay of the data mask relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. The lower two bits of the DQMDLY controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
25:23	RW	0x3	DQSNDLY DQS# Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are: 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps
22:20	RW	0x3	DQSDLY DQS Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are: 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps

Bit	Attr	Reset Value	Description
19:18	RW	0x1	<p>R3DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
17:16	RW	0x1	<p>R2DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
15:14	RW	0x1	<p>R1DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
13:12	RW	0x1	<p>R0DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
11:9	RW	0x0	<p>R3DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
8:6	RW	0x0	<p>R2DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
5:3	RW	0x0	<p>R1DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
2:0	RW	0x0	<p>R0DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none"> 000 = No extra clock cycles 001 = 1 extra clock cycle 010 = 2 extra clock cycles 011 = 3 extra clock cycles 100 = 4 extra clock cycles 101 = 5 extra clock cycles 110 = Reserved 111 = Reserved

DDR_PHYCTL_DX2GCR

Address: Operational Base + offset (0x0240)

DATX8 2 General Configuration Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RW	0x0	<p>RTTOAL</p> <p>RTT On Additive Latency: Indicates when the ODT control of DQ/DQS SSTL I/Os is set to the value in DQODT/DQSODT during read cycles.</p> <p>Valid values are:</p> <ul style="list-style-type: none"> 0 = ODT control is set to DQSODT/DQODT almost two cycles before read data preamble 1 = ODT control is set to DQSODT/DQODT almost one cycle before read data preamble

Bit	Attr	Reset Value	Description
12:11	RW	0x0	RTTOH RTT Output Hold: Indicates the number of clock cycles (from 0 to 3) after the read data postamble for which ODT control should remain set to DQSODT for DQS or DQODT for DQ/DM before disabling it (setting it to '0' when using dynamic ODT control. ODT is disabled almost RTTOH clock cycles after the read postamble)
10	RW	0x1	DQRTT DQ Dynamic RTT Control: Indicates, if set, that the ODT control of DQ/DM SSTL I/Os be dynamically controlled by setting it to the value in DQODT during reads and disabling it (setting it to '0' during any other cycle. If this bit is not set, then the ODT control of DQ SSTL I/Os is always set to the value in DQODT.
9	RW	0x1	DQSRTT DQS Dynamic RTT Control: Indicates, if set, that the ODT control of DQS SSTL I/Os be dynamically controlled by setting it to the value in DQSODT during reads and disabling it (setting it to 0 during any other cycle. If this bit is not set, then the ODT control of DQS SSTL I/Os is always set to the value in DQSODT field.
8:7	RW	0x1	DSEN Write DQS Enable: Controls whether the write DQS going to the SDRAM is enabled (toggling) or disabled (static value) and whether the DQS is inverted. DQS# is always the inversion of DQS. These values are valid only when DQS/DQS# output enable is on, otherwise the DQS/DQS# is tristated. Valid settings are: 00 = DQS disabled (Driven to constant 0) 01 = DQS toggling with inverted polarity 10 = DQS toggling with normal polarity (This should be the default setting) 11 = DQS disabled (Driven to constant 1)
6	RW	0x0	DQSRPD DQSR Power Down: Powers down, if set, the PDQSR cell. This bit is ORed with the common PDR configuration bit

Bit	Attr	Reset Value	Description
5	RW	0x0	DXPDR Data Power Down Receiver: Powers down, when set, the input receiver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDR configuration bit
4	RW	0x0	DXPDD Data Power Down Driver: Powers down, when set, the output driver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDD configuration bit
3	RW	0x0	DXIOM Data I/O Mode: Selects SSTL mode (when set to 0) or CMOS mode (when set to 1) of the I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the IOM configuration bit of the individual DATX8
2	RW	0x0	DQODT Data On-Die Termination: Enables, when set, the on-die termination on the I/O for DQ and DM pins of the byte. This bit is ORed with the common DATX8 ODT configuration bit
1	RW	0x0	DQSODT DQS On-Die Termination: Enables, when set, the on-die termination on the I/O for DQS/DQS# pin of the byte. This bit is ORed with the common DATX8 ODT configuration bit
0	RW	0x1	DXEN Data Byte Enable: Enables if set the DATX8 and SSTL I/Os used on the data byte. Setting this bit to '0' disables the byte, i.e. the byte SSTL I/Os are put in power-down mode and the DLL in the DATX8 is put in bypass mode.

DDR_PHYCTL_DX2GSR0

Address: Operational Base + offset (0x0244)

DATX8 2 General Status Register 0

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved

Bit	Attr	Reset Value	Description
24:13	RO	0x000	DTPASS Data Training Pass Count: The number of passing configurations during DQS gate training. Bits [2:0] are for rank 0, bits [5:3] for rank 1, and so on.
12	RO	0x0	reserved
11:8	RO	0x0	DTIERR Data Training Intermittent Error: If set, indicates that there was an intermittent error during data training of the byte, such as a pass was followed by a fail then followed by another pass. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
7:4	RO	0x0	DTERR Data Training Error: If set, indicates that a valid DQS gating window could not be found during data training of the byte. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
3:0	RO	0x0	DTDONE Data Training Done: Indicates, if set, that the byte has finished doing data training. Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX2GSR1

Address: Operational Base + offset (0x0248)

DATX8 2 General Status Register 1

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:4	RO	0x00	DQSDFT DQS Drift: Used to report the drift on the read data strobe of the data byte. Valid settings are: 00 = No drift 01 = 90 deg drift 10 = 180 deg drift 11 = 270 deg drift or more Bits [1:0] are for rank 0, bits [3:2] for rank 1, and so on.

Bit	Attr	Reset Value	Description
3:0	RO	0x0	DFTERR DQS Drift Error: If set, indicates that the byte read data strobe has drifted by more than or equal to the drift limit set in the PHY General Configuration Register (PGCR). Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX2DLLCR

Address: Operational Base + offset (0x024c)

DATX8 2 DLL Control Register

Bit	Attr	Reset Value	Description
31	RW	0x0	DLLDIS DLL Disable: A disabled DLL is bypassed. Default ('0') is DLL enabled.
30	RW	0x1	DLLSRST DLL Soft Rest: Soft resets the byte DLL by driving the DLL soft reset pin.
29:20	RO	0x0	reserved
19	RW	0x0	SDLBMODE Slave DLL Loopback Mode: If this bit is set, the slave DLL is put in loopback mode in which there is no 90 degrees phase shift on read DQS/DQS#. This bit must be set when operating the byte PHYs in loopback mode such as during BIST loopback. Applicable only to PHYs that have this feature. Refer to PHY databook.
18	RW	0x0	ATESTEN Analog Test Enable: Enables the analog test signal to be output on the DLL analog test output (test_out_a). The DLL analog test output is tri-stated when this bit is '0'.

Bit	Attr	Reset Value	Description																
17:14	RW	0x0	<p>SDPHASE Slave DLL Phase Trim: Selects the phase difference between the input clock and the corresponding output clock of the slave DLL. Valid settings:</p> <table> <tr><td>0000 = 90</td></tr> <tr><td>0001 = 72</td></tr> <tr><td>0010 = 54</td></tr> <tr><td>0011 = 36</td></tr> <tr><td>0100 = 108</td></tr> <tr><td>0101 = 90</td></tr> <tr><td>0110 = 72</td></tr> <tr><td>0111 = 54</td></tr> <tr><td>1000 = 126</td></tr> <tr><td>1001 = 108</td></tr> <tr><td>1010 = 90</td></tr> <tr><td>1011 = 72</td></tr> <tr><td>1100 = 144</td></tr> <tr><td>1101 = 126</td></tr> <tr><td>1110 = 108</td></tr> <tr><td>1111 = 90</td></tr> </table>	0000 = 90	0001 = 72	0010 = 54	0011 = 36	0100 = 108	0101 = 90	0110 = 72	0111 = 54	1000 = 126	1001 = 108	1010 = 90	1011 = 72	1100 = 144	1101 = 126	1110 = 108	1111 = 90
0000 = 90																			
0001 = 72																			
0010 = 54																			
0011 = 36																			
0100 = 108																			
0101 = 90																			
0110 = 72																			
0111 = 54																			
1000 = 126																			
1001 = 108																			
1010 = 90																			
1011 = 72																			
1100 = 144																			
1101 = 126																			
1110 = 108																			
1111 = 90																			
13:12	RW	0x0	<p>SSTART Slave Auto Start-Up: Used to control how the slave DLL starts up relative to the master DLL locking:</p> <table> <tr><td>0X = Slave DLL automatically starts up once the master DLL has achieved lock.</td></tr> <tr><td>10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled.</td></tr> <tr><td>11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.</td></tr> </table>	0X = Slave DLL automatically starts up once the master DLL has achieved lock.	10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled.	11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.													
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10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled.																			
11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.																			
11:9	RW	0x0	<p>MFWDLY Master Feed-Forward Delay Trim: Used to trim the delay in the master DLL feed-forward path:</p> <table> <tr><td>000 = minimum delay</td></tr> <tr><td>111 = maximum delay</td></tr> </table>	000 = minimum delay	111 = maximum delay														
000 = minimum delay																			
111 = maximum delay																			
8:6	RW	0x0	<p>MFBDLY Master Feed-Back Delay Trim: Used to trim the delay in the master DLL feedbackpath:</p> <table> <tr><td>000 = minimum delay</td></tr> <tr><td>111 = maximum delay</td></tr> </table>	000 = minimum delay	111 = maximum delay														
000 = minimum delay																			
111 = maximum delay																			

Bit	Attr	Reset Value	Description
5:3	RW	0x0	SFWDLY Slave Feed-Forward Delay Trim: Used to trim the delay in the slave DLL feed-forward path: 000 = minimum delay 111 = maximum delay
2:0	RW	0x0	SFBDLY Slave Feed-Back Delay Trim: Used to trim the delay in the slave DLL feedback path: 000 = minimum delay 111 = maximum delay

DDR_PHYCTL_DX2DQTR

Address: Operational Base + offset (0x0250)

DATX8 2 DQ Timing Register

Bit	Attr	Reset Value	Description
31:28	RW	0xf	DQDLY7 DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are: 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
27:24	RW	0xf	<p>DQDLY6</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
23:20	RW	0xf	<p>DQDLY5</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
19:16	RW	0xf	<p>DQDLY4</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
15:12	RW	0xf	<p>DQDLY3</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
11:8	RW	0xf	<p>DQDLY2</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
7:4	RW	0xf	<p>DQDLY1</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
3:0	RW	0xf	<p>DQDLY0</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

DDR_PHYCTL_DX2DQSTR

Address: Operational Base + offset (0x0254)

DATX8 2 DQS Timing Register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	reserved
29:26	RW	0xf	<p>DMDLY</p> <p>DM Delay: Used to adjust the delay of the data mask relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. The lower two bits of the DQMDLY controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
25:23	RW	0x3	DQSNDLY DQS# Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are: 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps
22:20	RW	0x3	DQSDLY DQS Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are: 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps

Bit	Attr	Reset Value	Description
19:18	RW	0x1	<p>R3DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
17:16	RW	0x1	<p>R2DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
15:14	RW	0x1	<p>R1DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
13:12	RW	0x1	<p>R0DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
11:9	RW	0x0	<p>R3DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
8:6	RW	0x0	<p>R2DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
5:3	RW	0x0	<p>R1DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
2:0	RW	0x0	<p>R0DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none"> 000 = No extra clock cycles 001 = 1 extra clock cycle 010 = 2 extra clock cycles 011 = 3 extra clock cycles 100 = 4 extra clock cycles 101 = 5 extra clock cycles 110 = Reserved 111 = Reserved

DDR_PHYCTL_DX3GCR

Address: Operational Base + offset (0x0280)

DATX8 3 General Configuration Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RW	0x0	<p>RTTOAL</p> <p>RTT On Additive Latency: Indicates when the ODT control of DQ/DQS SSTL I/Os is set to the value in DQODT/DQSODT during read cycles.</p> <p>Valid values are:</p> <ul style="list-style-type: none"> 0 = ODT control is set to DQSODT/DQODT almost two cycles before read data preamble 1 = ODT control is set to DQSODT/DQODT almost one cycle before read data preamble

Bit	Attr	Reset Value	Description
12:11	RW	0x0	RTTOH RTT Output Hold: Indicates the number of clock cycles (from 0 to 3) after the read data postamble for which ODT control should remain set to DQSODT for DQS or DQODT for DQ/DM before disabling it (setting it to '0' when using dynamic ODT control. ODT is disabled almost RTTOH clock cycles after the read postamble)
10	RW	0x1	DQRTT DQ Dynamic RTT Control: Indicates, if set, that the ODT control of DQ/DM SSTL I/Os be dynamically controlled by setting it to the value in DQODT during reads and disabling it (setting it to '0' during any other cycle. If this bit is not set, then the ODT control of DQ SSTL I/Os is always set to the value in DQODT.
9	RW	0x1	DQSRTT DQS Dynamic RTT Control: Indicates, if set, that the ODT control of DQS SSTL I/Os be dynamically controlled by setting it to the value in DQSODT during reads and disabling it (setting it to 0 during any other cycle. If this bit is not set, then the ODT control of DQS SSTL I/Os is always set to the value in DQSODT field.
8:7	RW	0x1	DSEN Write DQS Enable: Controls whether the write DQS going to the SDRAM is enabled (toggling) or disabled (static value) and whether the DQS is inverted. DQS# is always the inversion of DQS. These values are valid only when DQS/DQS# output enable is on, otherwise the DQS/DQS# is tristated. Valid settings are: 00 = DQS disabled (Driven to constant 0) 01 = DQS toggling with inverted polarity 10 = DQS toggling with normal polarity (This should be the default setting) 11 = DQS disabled (Driven to constant 1)
6	RW	0x0	DQSRPD DQSR Power Down: Powers down, if set, the PDQSR cell. This bit is ORed with the common PDR configuration bit

Bit	Attr	Reset Value	Description
5	RW	0x0	DXPDR Data Power Down Receiver: Powers down, when set, the input receiver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDR configuration bit
4	RW	0x0	DXPDD Data Power Down Driver: Powers down, when set, the output driver on I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the common PDD configuration bit
3	RW	0x0	DXIOM Data I/O Mode: Selects SSTL mode (when set to 0) or CMOS mode (when set to 1) of the I/O for DQ, DM, and DQS/DQS# pins of the byte. This bit is ORed with the IOM configuration bit of the individual DATX8
2	RW	0x0	DQODT Data On-Die Termination: Enables, when set, the on-die termination on the I/O for DQ and DM pins of the byte. This bit is ORed with the common DATX8 ODT configuration bit
1	RW	0x0	DQSODT DQS On-Die Termination: Enables, when set, the on-die termination on the I/O for DQS/DQS# pin of the byte. This bit is ORed with the common DATX8 ODT configuration bit
0	RW	0x1	DXEN Data Byte Enable: Enables if set the DATX8 and SSTL I/Os used on the data byte. Setting this bit to '0' disables the byte, i.e. the byte SSTL I/Os are put in power-down mode and the DLL in the DATX8 is put in bypass mode.

DDR_PHYCTL_DX3GSR0

Address: Operational Base + offset (0x0284)

DATX8 3 General Status Register 0

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved

Bit	Attr	Reset Value	Description
24:13	RO	0x000	DTPASS Data Training Pass Count: The number of passing configurations during DQS gate training. Bits [2:0] are for rank 0, bits [5:3] for rank 1, and so on.
12	RO	0x0	reserved
11:8	RO	0x0	DTIERR Data Training Intermittent Error: If set, indicates that there was an intermittent error during data training of the byte, such as a pass was followed by a fail then followed by another pass. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
7:4	RO	0x0	DTERR Data Training Error: If set, indicates that a valid DQS gating window could not be found during data training of the byte. Bit [0] is for rank 0, bit 1 for rank 1, and so on.
3:0	RO	0x0	DTDONE Data Training Done: Indicates, if set, that the byte has finished doing data training. Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX3GSR1

Address: Operational Base + offset (0x0288)

DATX8 3 General Status Register 1

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:4	RO	0x00	DQSDFT DQS Drift: Used to report the drift on the read data strobe of the data byte. Valid settings are: 00 = No drift 01 = 90 deg drift 10 = 180 deg drift 11 = 270 deg drift or more Bits [1:0] are for rank 0, bits [3:2] for rank 1, and so on.

Bit	Attr	Reset Value	Description
3:0	RO	0x0	DFTERR DQS Drift Error: If set, indicates that the byte read data strobe has drifted by more than or equal to the drift limit set in the PHY General Configuration Register (PGCR). Bit [0] is for rank 0, bit 1 for rank 1, and so on.

DDR_PHYCTL_DX3DLLCR

Address: Operational Base + offset (0x028c)

DATX8 3 DLL Control Register

Bit	Attr	Reset Value	Description
31	RW	0x0	DLLDIS DLL Disable: A disabled DLL is bypassed. Default ('0') is DLL enabled.
30	RW	0x1	DLLSRST DLL Soft Rest: Soft resets the byte DLL by driving the DLL soft reset pin.
29:20	RO	0x0	reserved
19	RW	0x0	SDLBMODE Slave DLL Loopback Mode: If this bit is set, the slave DLL is put in loopback mode in which there is no 90 degrees phase shift on read DQS/DQS#. This bit must be set when operating the byte PHYs in loopback mode such as during BIST loopback. Applicable only to PHYs that have this feature. Refer to PHY databook.
18	RW	0x0	ATESTEN Analog Test Enable: Enables the analog test signal to be output on the DLL analog test output (test_out_a). The DLL analog test output is tri-stated when this bit is '0'.

Bit	Attr	Reset Value	Description																
17:14	RW	0x0	<p>SDPHASE Slave DLL Phase Trim: Selects the phase difference between the input clock and the corresponding output clock of the slave DLL. Valid settings:</p> <table> <tr><td>0000 = 90</td></tr> <tr><td>0001 = 72</td></tr> <tr><td>0010 = 54</td></tr> <tr><td>0011 = 36</td></tr> <tr><td>0100 = 108</td></tr> <tr><td>0101 = 90</td></tr> <tr><td>0110 = 72</td></tr> <tr><td>0111 = 54</td></tr> <tr><td>1000 = 126</td></tr> <tr><td>1001 = 108</td></tr> <tr><td>1010 = 90</td></tr> <tr><td>1011 = 72</td></tr> <tr><td>1100 = 144</td></tr> <tr><td>1101 = 126</td></tr> <tr><td>1110 = 108</td></tr> <tr><td>1111 = 90</td></tr> </table>	0000 = 90	0001 = 72	0010 = 54	0011 = 36	0100 = 108	0101 = 90	0110 = 72	0111 = 54	1000 = 126	1001 = 108	1010 = 90	1011 = 72	1100 = 144	1101 = 126	1110 = 108	1111 = 90
0000 = 90																			
0001 = 72																			
0010 = 54																			
0011 = 36																			
0100 = 108																			
0101 = 90																			
0110 = 72																			
0111 = 54																			
1000 = 126																			
1001 = 108																			
1010 = 90																			
1011 = 72																			
1100 = 144																			
1101 = 126																			
1110 = 108																			
1111 = 90																			
13:12	RW	0x0	<p>SSTART Slave Auto Start-Up: Used to control how the slave DLL starts up relative to the master DLL locking:</p> <table> <tr><td>0X = Slave DLL automatically starts up once the master DLL has achieved lock.</td></tr> <tr><td>10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled.</td></tr> <tr><td>11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.</td></tr> </table>	0X = Slave DLL automatically starts up once the master DLL has achieved lock.	10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled.	11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.													
0X = Slave DLL automatically starts up once the master DLL has achieved lock.																			
10 = The automatic startup of the slave DLL is disabled; the phase detector is disabled.																			
11 = The automatic startup of the slave DLL is disabled; the phase detector is enabled.																			
11:9	RW	0x0	<p>MFWDLY Master Feed-Forward Delay Trim: Used to trim the delay in the master DLL feed-forward path:</p> <table> <tr><td>000 = minimum delay</td></tr> <tr><td>111 = maximum delay</td></tr> </table>	000 = minimum delay	111 = maximum delay														
000 = minimum delay																			
111 = maximum delay																			
8:6	RW	0x0	<p>MFBDLY Master Feed-Back Delay Trim: Used to trim the delay in the master DLL feedback path:</p> <table> <tr><td>000 = minimum delay</td></tr> <tr><td>111 = maximum delay</td></tr> </table>	000 = minimum delay	111 = maximum delay														
000 = minimum delay																			
111 = maximum delay																			

Bit	Attr	Reset Value	Description
5:3	RW	0x0	SFWDLY Slave Feed-Forward Delay Trim: Used to trim the delay in the slave DLL feed-forward path: 000 = minimum delay 111 = maximum delay
2:0	RW	0x0	SFBDLY Slave Feed-Back Delay Trim: Used to trim the delay in the slave DLL feedback path: 000 = minimum delay 111 = maximum delay

DDR_PHYCTL_DX3DQTR

Address: Operational Base + offset (0x0290)

DATX8 3 DQ Timing Register

Bit	Attr	Reset Value	Description
31:28	RW	0xf	DQDLY7 DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are: 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
27:24	RW	0xf	<p>DQDLY6</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
23:20	RW	0xf	<p>DQDLY5</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
19:16	RW	0xf	<p>DQDLY4</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
15:12	RW	0xf	<p>DQDLY3</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
11:8	RW	0xf	<p>DQDLY2</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps
7:4	RW	0xf	<p>DQDLY1</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
3:0	RW	0xf	<p>DQDLY0</p> <p>DQ Delay: Used to adjust the delay of the data relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. Every four bits of this register control the delay of a different data bit in the byte. DQDLY0 controls the delay of data bit [0], DQDLY1 controls data bit [1], and so on. The lower two bits of the DQDLY for each DQ bit controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b. Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

DDR_PHYCTL_DX3DQSTR

Address: Operational Base + offset (0x0294)

DATX8 3 DQS Timing Register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	reserved
29:26	RW	0xf	<p>DMDLY</p> <p>DM Delay: Used to adjust the delay of the data mask relative to the nominal delay that is matched to the delay of the data strobes through the slave DLL and clock tree. The lower two bits of the DQMDLY controls the delay for the data clocked by DQS, while the higher two bits control the delay for the data clocked by DQS_b.</p> <p>Valid settings for each 2-bit control field are:</p> <ul style="list-style-type: none"> 00 = nominal delay 01 = nominal delay + 1 step 10 = nominal delay + 2 steps 11 = nominal delay + 3 steps

Bit	Attr	Reset Value	Description
25:23	RW	0x3	<p>DQSNDLY</p> <p>DQS# Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are:</p> <ul style="list-style-type: none"> 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps
22:20	RW	0x3	<p>DQSDLY</p> <p>DQS Delay: Used to adjust the delay of the data strobes relative to the nominal delay that is matched to the delay of the data bit through the slave DLL and clock tree. DQSDLY control the delay on DQS strobe and DQSNDLY control the delay on DQS#. Valid values are:</p> <ul style="list-style-type: none"> 000 = nominal delay - 3 steps 001 = nominal delay - 2 steps 010 = nominal delay - 1 step 011 = nominal delay 100 = nominal delay + 1 step 101 = nominal delay + 2 steps 110 = nominal delay + 3 steps 111 = nominal delay + 4 steps

Bit	Attr	Reset Value	Description
19:18	RW	0x1	<p>R3DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
17:16	RW	0x1	<p>R2DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
15:14	RW	0x1	<p>R1DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
13:12	RW	0x1	<p>R0DGPS</p> <p>Rank n DQS Gating Phase Select: Selects the clock used to enable the data strobes during read so that the value of the data strobes before and after the preamble/postamble are filtered out. The RnDGPS fields are initially set by the PHYCTL during automatic DQS data training and subsequently updated during data strobe drift compensation. However, these values can be overwritten by a direct write to this register, and the automatic update during DQS drift compensation can be disabled using the PHY General Configuration Register (PGCR). Every two bits of this register control the DQS gating for each of the (up to) four ranks. R0DGPS controls the DQS gating for rank 0, R1DGPS controls rank 1, and so on. Valid values for each 2-bit RnDGPS field are:</p> <ul style="list-style-type: none">00 = 90 deg clock (clk90)01 = 180 deg clock (clk180)10 = 270 deg clock (clk270)11 = 360 deg clock (clk0)

Bit	Attr	Reset Value	Description
11:9	RW	0x0	<p>R3DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
8:6	RW	0x0	<p>R2DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
5:3	RW	0x0	<p>R1DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none">000 = No extra clock cycles001 = 1 extra clock cycle010 = 2 extra clock cycles011 = 3 extra clock cycles100 = 4 extra clock cycles101 = 5 extra clock cycles110 = Reserved111 = Reserved

Bit	Attr	Reset Value	Description
2:0	RW	0x0	<p>R0DGSL</p> <p>Rank n DQS Gating System Latency: Used to increase the number of clock cycles needed to expect valid DDR read data by up to five extra clock cycles. This is used to compensate for board delays and other system delays.</p> <p>Power-up default is 000 (i.e. no extra clock cycles required). The SL fields are initially set by the PHYCTL during automatic DQS data training but these values can be overwritten by a direct write to this register. Every three bits of this register control the latency of each of the (up to) four ranks. R0DGSL controls the latency of rank 0, R1DGSL controls rank 1, and so on. Valid values are:</p> <ul style="list-style-type: none"> 000 = No extra clock cycles 001 = 1 extra clock cycle 010 = 2 extra clock cycles 011 = 3 extra clock cycles 100 = 4 extra clock cycles 101 = 5 extra clock cycles 110 = Reserved 111 = Reserved

13.6 Timing Diagram

13.6.1 DDR3 Read/Write Access Timing

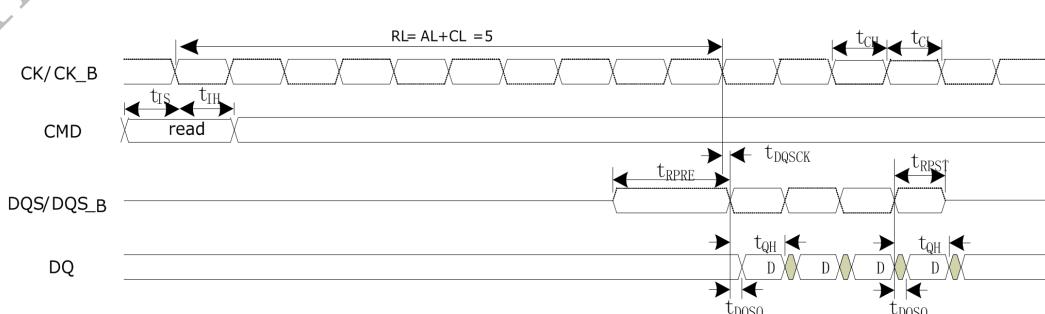
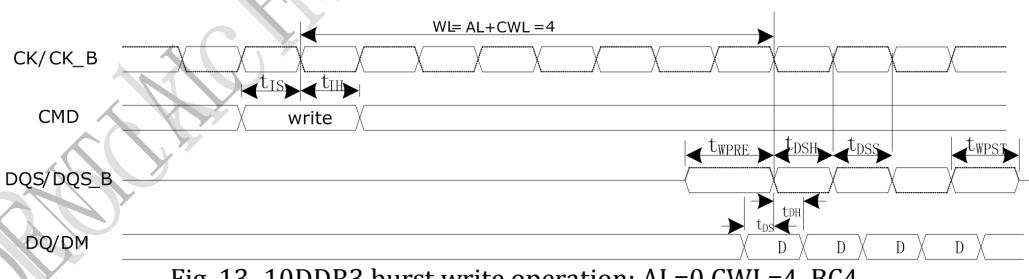


Table 13- 17 meaning of the parameter in Fig.13-10 and Fig.13-11

Parameter	Description	DDR3-800		unit
		min	max	
t_{CH}	CK HIGH pulse width	0.43	-	tCK
t_{CL}	CK LOW pulse width	0.43	-	tCK
t_{DS}	DQ and DM input setup time (differential strobe)	75	-	ps
t_{DH}	DQ and DM input hold time (differential strobe)	150	-	ps
t_{DSS}	DQS falling edge to CK setup time	0.2	-	tCK
t_{DSH}	DQS falling edge hold time from CK	0.2	-	tCK
t_{IS}	Address and control input setup time	200	-	ps
t_{IH}	Address and control input hold time	275	-	ps
t_{WPRE}	Write preamble	0.9	-	tCK
t_{WPST}	Write postamble	0.3	-	tCK
t_{RPRE}	Read preamble	0.9	1.1	tCK
t_{RPST}	Read postamble	0.3	0.5	tCK
t_{DQSCK}	DQS output access time from CK/CK_n	-400	+400	ps
t_{DQSQ}	DQS-DQ skew for DQS and associated DQ signals	-	200	ps
t_{QH}	DQ/DQS output hold time from DQS	0.38	-	tCK

13.6.2 LPDDR2 Read/Write Access Timing

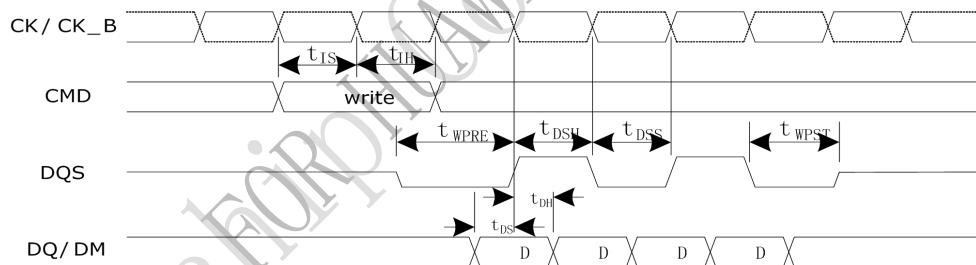


Fig. 13- 12LPDDR2 burst write operation: WL=1,BL=4

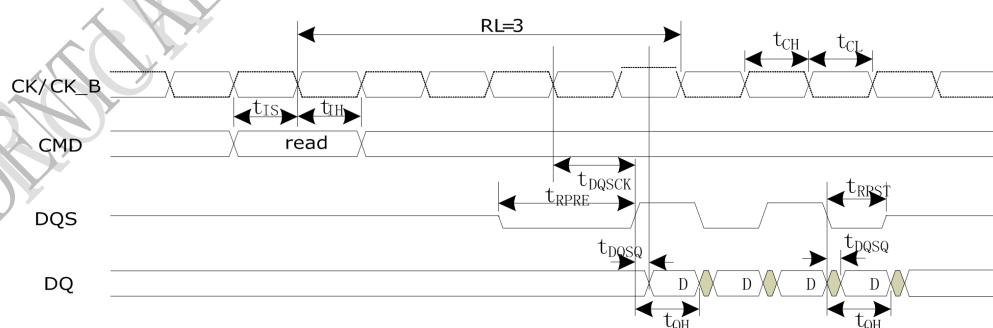


Fig. 13- 13LPDDR2 burst read operation: RL=3, BL=4

Table 13- 18 meaning of the parameter in Fig.13-12 and Fig.13-13

Parameter	Description	LPDDR2 S4-800		unit
		min	max	
t_{CH}	CK HIGH pulse width	0.43	0.57	tCK
t_{CL}	CK LOW pulse width	0.43	0.57	tCK

t_{DS}	DQ and DM input setup time	0.27	-	ns
t_{DH}	DQ and DM input hold time	0.27	-	ns
t_{DSS}	DQS falling edge to CK setup time	0.2	-	tCK
t_{DSH}	DQS falling edge hold time from CK	0.2	-	tCK
t_{IS}	Address and control input setup time	0.29	-	ns
t_{IH}	Address and control input hold time	0.29	-	ns
t_{WPRE}	Write preamble	0.35	-	tCK
t_{WPST}	Write postamble	0.4	-	tCK
t_{RPRE}	Read preamble	0.9	-	tCK
t_{RPST}	Read postamble	$t_{CL} - 0.05$	$t_{CL} - 0.05$	tCK
t_{DQSCK}	DQS output access time from CK/CK_n	2.5	5.5	ns
t_{DQSQ}	DQS-DQ skew for DQS and associated DQ signals	0.24	0.28	ns
t_{QH}	DQ/DQS output hold time from DQS	$t_{QHP} - t_{QHS}$	-	ns
RL	Read Latency	6		
WL	Write Latency	3		

13.7 Interface description

DDR IOs are listed as following Table.

Pin Name	Description
CK	Active-high clock signal to the memory device.
CK_B	Active-low clock signal to the memory device.
CKE _i (i=0,1)	Active-high clock enable signal to the memory device for two chip select.
CS_B _i (i=0,1)	Active-low chip select signal to the memory device. ATThere are two chip select.
RAS_B	Active-low row address strobe to the memory device.
CAS_B	Active-low column address strobe to the memory device.
WE_B	Active-low write enable strobe to the memory device.
BA[2:0]	Bank address signal to the memory device.
A[15:0]	Address signal to the memory device.
DQ[31:0]	Bidirectional data line to the memory device.
DQS[3:0]	Active-high bidirectional data strobes to the memory device.
DQS_B[3:0]	Active-low bidirectional data strobes to the memory device.
DM[3:0]	Active-low data mask signal to the memory device.
ODT _i (i=0,1)	On-Die Termination output signal for two chip select.
RET_EN	Active-low retention latch enable input.
VREF _i (i=0,1,2)	Reference Voltage input for three regions of DDR IO.
ZQ_PIN	ZQ calibration pad which connects 240ohm±1% resistor.
RESET	DDR3 reset signal.

13.8 Application Notes

13.8.1 State transition of PCTL

To operate PCTL, the programmer must be familiar with the available operational states and how to transition to each state from the current state.

Every software programmable register is accessible only during certain operational states. For information about what registers are accessible in each state, refer to “Software Registers,” which provides this information in each register description. The general rule is that the PCTL must be in the Init_mem or Config states to successfully write most of the registers.

The following tables provide the programming sequences for moving to the various states of the state machine.

Moving to the Init_mem State

Step	Application	PCTL
1	Read STAT register	Returns the current PCTL state.
2	If STAT.ctl_stat = Init_mem, go to END.	
3	If STAT.ctl_stat = Config, go to Step 9.	
4	If STAT.ctl_stat = Access, go to Step 8.	
5	If STAT.ctl_stat = Low_power, go to Step 7.	
6	Goto Step 1.	PCTL is in a transitional state and not in any of the previous operational states.
7	Write WAKEUP to SCTL.state_cmd and poll STAT.ctl_stat = Access.	Issues SRX, moves to the Access state, updates STAT.ctl_stat = Access when complete.
8	Write CFG to SCTL.state_cmd and poll STAT.ctl_stat = Config.	PCTL stalls the NIF; completes any pending transaction; issues PREA if required; moves into the Config state; updates STAT.ctl_stat = Config when complete.
9	Write INIT to SCTL.state_cmd and poll STAT.ctl_stat = Init_mem	Moves into the Init_mem state and updates STAT.ctl_stat = Init_mem.
END		PCTL is in Init_mem state.

Moving to Config State

Step	Application	PCTL
1	Read STAT register.	Returns the current PCTL state.
2	If STAT.ctl_stat = Config, goto END.	
3	If STAT.ctl_stat = Low_power, goto Step 6.	
4	If STAT.ctl_stat = Init_mem or Access, goto Step 7.	
5	Goto Step 1.	PCTL is in a transitional state and is not in any of the previous operational states.

6	WriteWAKEUPtoSCTL.state_cmdand poll STAT.ctl_stat= Access.	Issues SRX,movesto theAccess state, and updates STAT.ctl_stat= Access when complete.
7	WriteCFGtoSCTL.state_cmdand poll STAT.ctl_stat= Config.	PCTLstalls the NIF; completesany pending transaction; issuesPREAif required;moves into the Configstate; and updates STAT.ctl_stat = Config whencomplete.
END		PCTLis in Configstate.

Moving to Access State

Step	Application	PCTL
1	Read STAT register	Returns the current PCTLstate.
2	If STAT.ctl_stat= Access ,goto END.	
3	If STAT.ctl_stat= Config , gotoStep9	
4	If STAT.ctl_stat= Init_mem , gotoStep8	
5	If STAT.ctl_stat= Low_power ,go to Step7.	
6	GotoStep1.	PCTLis in a transitional state and is not in any of the previous operational states.
7	WriteWAKEUPtoSCTL.state_cmdandpoll STAT.ctl_stat= Access .GotoEND	Issues SRX,movesto theAccess state,updates STAT.ctl_stat= Access when complete.
8	WriteCFGtoSCTL.state_cmdandpoll STAT.ctl_stat= Config.	Moves into the Configstate, updates STAT.ctl_stat= Config when complete.
9	WriteGOtoSCTL.state_cmd andpoll STAT.ctl_stat= Access.	Moves into the Access state, updates STAT.ctl_stat= Access when complete.
END		PCTLis in Access state.

Moving to Low Power State

Step	Application	PCTL
1	Read STAT register.	Returns current PCTL state.
2	If STAT.ctl_stat =Low_power , goto END.	
3	If STAT.ctl_stat = Access , gotoStep9	
4	If STAT.ctl_stat = Config , gotoStep8	
5	If STAT.ctl_stat = Init_mem , go toStep7.	
6	Goto Step1.	PCTL is in transitional state and is not in any of the previous operational states.
7	WriteCFG to SCTL.state_cmd and poll STAT.ctl_stat= Config.	Moves into the Configstate, updates STAT.ctl_stat = Config when complete.
8	WriteGOtoSCTL.state_cmdandpoll STAT.ctl_stat= Access.	Moves into the Access state, updates STAT.ctl_stat = Access when complete.

9	WriteSLEEPtoSCTL.state_cmdandpoll STAT.ctl_stat =Low_power.	IssuesPDXif necessary; completes any pending transactions; issuesPREAcommand; finally, issuesSRE and updates STAT.ctl_stat = Low_power.
END		PCTLis inLowPowerstate

13.8.2 Initialization

Figure 13-14 shows a high-level illustration of the initialization sequence of the PHY. A detailed sequence description and timing diagrams are described in the following. This section assumes a generic configuration port and therefore cfg_clk and cfg_rst_n are shown as the configuration clock and reset, respectively. These signals must be replaced by pclk and presetn if the design is compiled to use the APB configuration port.

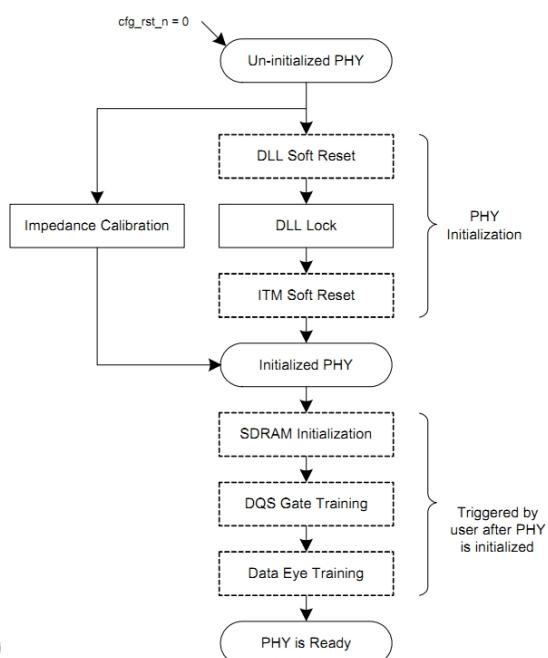


Fig. 13-14 Protocol controller architecture

PHY Initialization

The initialization sequence has two phases. The first phase happens automatically at reset and is as follows:

1. Before and during configuration reset (i.e. if cfg_rst_n is asserted), the PHY is un-initialized and remains in this state until the reset is de-asserted.
2. At reset de-assertion, the PHY moves into the DLL initialization (lock) phase. This phase may be bypassed at any time by writing a '1' to the DLL initialization bypass register bit (PIR[LOCKBYP]).
3. In parallel to DLL initialization, the impedance calibration phase also starts at reset de-assertion.

This phase can also be bypassed by writing a '1' to the impedance calibration bypass register bit-PIR[ZCALBYP].

4. If the PHY initialization sequence was triggered by the user, a soft reset may optionally be selected to be issued to the ITMs. Initialization that is automatically triggered on reset does not issue a soft reset to the ITMs because the components will already have been reset by the main reset.

5. Once the DLL initialization and impedance calibration phases are done and after the ITMs are reset, the PHY is initialized. Note that if these phases were bypassed, it is up to the user to perform them in software or trigger them at a later time before the PHY can be used.

SDRAM Initialization

The second phase of initialization starts after the PHY is initialized. Each step of this phase is triggered by the user or memory controller and is as follows:

1. Prior to normal operation, DDR SDRAMs must be initialized. The PHYCTL has a built-in SDRAM initialization routine that may be triggered by software or memory controller by writing to the PHY Initialization Register (PIR). The initialization routine built into the PHYCTL is generic and does not require any knowledge of the type or configuration of external SDRAMs to be properly executed. The routine is designed with the relevant JEDEC specifications for the fastest & slowest SDRAMs supported by the PHYCTL to result in a universal initialization sequence. This generic sequence is applicable to DDR3, DDR2, LPDDR2, LPDDR, and DDR SDRAMs.

It is recommended to use the built-in PHYCTL routine to initialize the SDRAM. However, there may be cases such as during system debug when the built-in PHYCTL DRAM initialization is not triggered and DRAM initialization is performed by software or the controller. In these cases the system must first wait for the PHY to initialize, i.e. DLL locked and impedance calibration done, then it must write a '1' to PIR[INIT] bit with PIR[CTLDINT] set to '1' (for controller initialization) or '0' (for software or PHYCTL initialization) to inform the PHYCTL that DRAM initialization will be done later, by software, the controller or by re-triggering on the PHYCTL. The software or controller then executes the initialization sequence by sending relevant commands to the DRAM, respecting the various timing requirements of the initialization sequence.

2. After the SDRAM is initialized, the user or memory controller performs, or triggers the PHYCTL to perform DQS gate training ("Built-in DQS Gate Training" on page 114). The SDRAM must be initialized before triggering DQS gate training.

3. The user or memory controller performs, or triggers the PHYCTL to perform read data eye training. Note that the current version of the PHYCTL does not have the read eye training designed in.

4. The PHY is now ready for SDRAM read/write accesses.

DDR3 Initialization Sequence

The initialization steps for DDR3 SDRAMs are as follows:

1. Optionally maintain RESET# low for a minimum of either 200 us (power-up initialization) or 100ns (power-on initialization). The PHYCTL drives RESET# low from the beginning of reset assertion and therefore this step may be skipped when DRAM initialization is triggered if enough time may already have expired to satisfy the RESET# low time.

2. After RESET# is de-asserted, wait a minimum of 500 us with CKE low.

3. Apply NOP and drive CKE high.

4. Wait a minimum of tXPR.

5. Issue a load Mode Register 2 (MR2) command.

6. Issue a load Mode Register 3 (MR3) command.

7. Issue a load Mode Register (MR1) command (to set parameters and enable DLL).

8. Issue a load Mode Register (MR0) command to set parameters and reset DLL.

9. Issue ZQ calibration command.

10. Wait 512 SDRAM clock cycles for the DLL to lock (tDLLK) and ZQ calibration (tZQinit) to finish. This wait time is relative to Step 8, i.e. relative to when the DLL reset command was issued onto the SDRAM command bus.

LPDDR2 Initialization Sequence

The initialization steps for LPDDR2 SDRAMs are as follows:

1. Wait a minimum of 100 ns (tINIT1) with CKE driven low.
2. Apply NOP and set CKE high.
3. Wait a minimum of 200 us (tINIT3).
4. Issue a RESET command.
5. Wait a minimum of 1 us + 10 us (tINIT4 + tINIT5).
6. Issue a ZQ calibration command.
7. Wait a minimum of 1 us (tZQINIT).
8. Issue a Write Mode Register to MR1.
9. Issue a Write Mode Register to MR2
10. Issue a Write Mode Register to MR3

Initialization Triggered and bypass

All initialization steps shown in Figure 3-1 on page 34 can be triggered using the PHY Initialization Register (PIR) as described in "PHY Initialization Register (PIR)" on page 47. Writing a '1' to PIR[INIT] register bit will start initialization, with the routines to be run being selected by the corresponding PIR register bits. If multiple routines are selected, they are run in the order shown in Figure 3-1 on page 34. This is also the order of the select bits in PIR register. The completion of the routines is indicated in the PHY General Status Register (PGSR) with the corresponding done status bits (see "PHY General Status Register (PGSR)" on page 52). The PGSR[IDONE] bit indicates the overall completion of the initialization sequence. An initialization done status register bit is cleared (reset to '0') when the corresponding routine is re-triggered.

The de-assertion of reset will automatically trigger the PHYCTL to perform DLL initialization (locking) and impedance calibration. Once the DLL has locked and impedance calibration has completed, the SDRAM initialization and DQS gating may be triggered or performed by software or memory controller.

Since the PHYCTL allows the selection of individual routines to be run when initialization is triggered using PIR register, only those routines that automatically trigger on reset de-assertion have individual bypass capability. This means that DLL locking and/or impedance calibration may be bypassed any time by writing a '1' to the corresponding bypass register bit in the PIR register. Once a routine is bypassed, it is internally registered as completed and the corresponding done status register bit is set in the PGSR register.

It is up to the user to re-trigger or perform the bypassed routine at a later time before the PHY can be used. The PIR[INITBYP] register bit provides the option to bypass the whole initialization sequence.

13.8.3 MDLL and MSDLL Reset Requirements

Reset issued to the MDLL and MSDLL must always meet the following requirements:

1. Reset must always be asserted for a minimum of 50ns to ensure proper reset of the DLL.
2. On power-up, reset must be held for a minimum of 50ns after MVDD has been raised to its full value.
3. After reset has been asserted and then de-asserted, a number of clock cycles must pass for the DLL to achieve lock.
4. The input clock to the DLL must be stable for a minimum of 50ns before DLL

reset is de-asserted.

The following additional requirements apply when transitioning to/from bypass mode:

1. There must be at least 50ns between reset de-assertion and DLL bypass mode entry.
2. The DLL bypass pin must be asserted for at least 1000ns.
3. Reset must always be issued after the DLL mode has changed from bypass to normal mode.
4. A minimum of 100ns is required between bypass de-assertion and reset assertion.
5. Reset must be issued whenever DLL control/trim/option input bits are modified, with the exception of:

- a. Analog/digital test controls
- b. Slave DLL phase trim (if applicable).

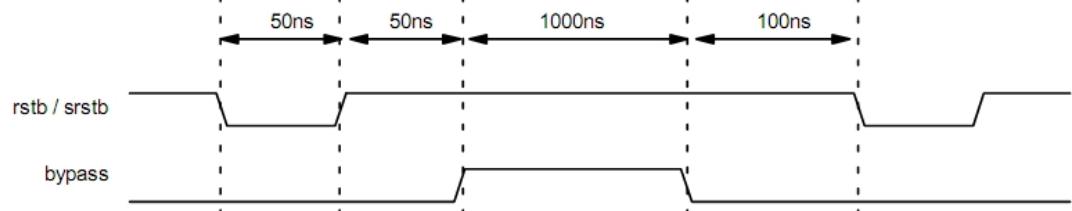


Fig. 13-15 DLL reset requirements

13.8.4 Data Training

Built-in DQS Gate Training

The PHYCTL has a built-in DQS gate training routine that may be triggered by software or memory controller using the PIR register.

DQS gate training returns a number of status, including the done and error status. There are two types of errors. The first type is when no valid window was found for the byte. This is indicated by DTERR register bit in DXnGSR and PGSR registers. This is usually an indication of bad configuration. The second type is when some passing configurations were found but these were interspersed by failures. This is not expected in a working system. A typical window is signified by consecutive passes followed by consecutive failures, e.g. FPPPPPF and not FPPFPPF. This type of error is called an intermittent error and is indicated by the DTIERR register bit in DXnGSR and PGSR registers. Provided for debug purpose is the status of how many passing configurations were found for each byte on each rank. This is indicated by DTPASS field in the DXnGSR register.

Software DQS Gate Training

DQS gate training may also be executed in software using the controller and/or the PUB DCU. Figure 13-16 shows the DQS gate training software algorithm. This is followed by a description of the main phases of the training.

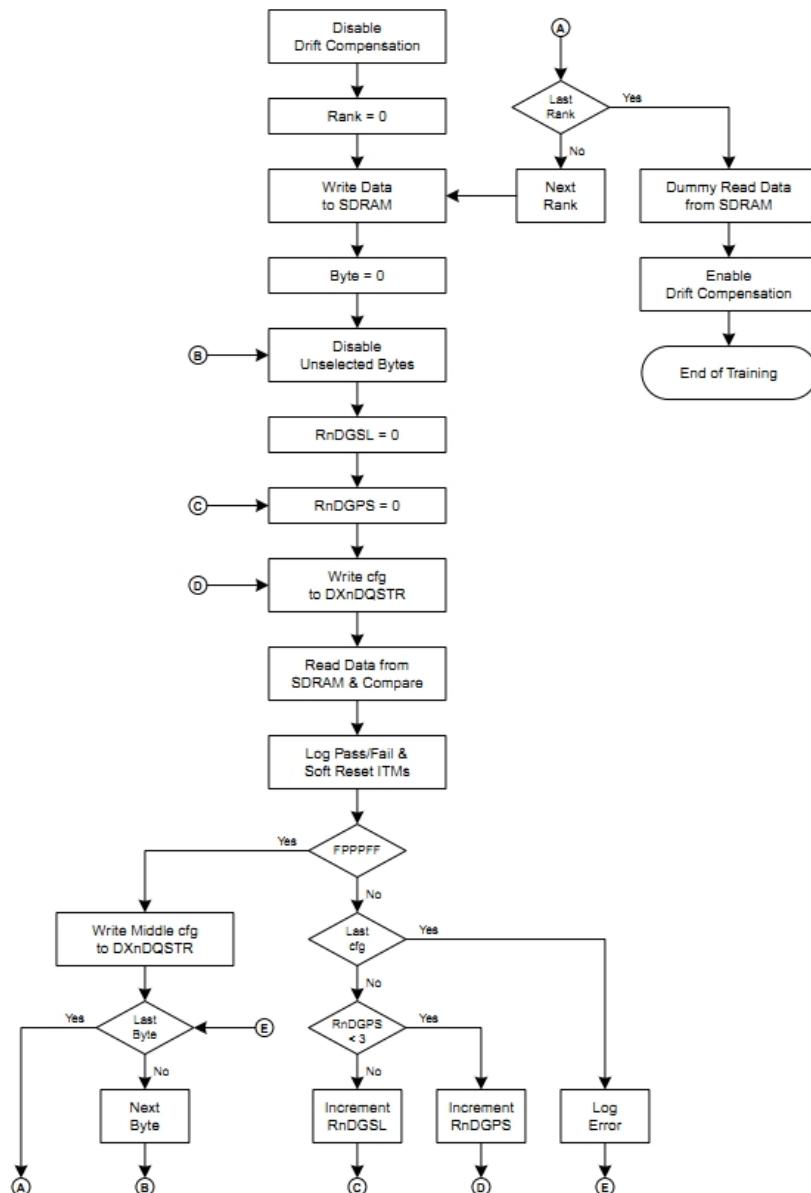


Fig. 13- 16DLL reset requirements

The software DQS gate training phases are as follows:

1. Disable drift compensation by writing '0' to PGCR.DFTCMP register.
2. Start with rank 0, i.e. rank 0 is selected for training.
3. Execute a minimum of two writes to the SDRAM. Any type of data and any SDRAM address can be used for DQS gate training. It is however not recommended to use data that is all zeroes since this may mask read data comparison. The data mask must be set to 0 to enable writing of all bytes. The number of writes must be chosen such that it results in a minimum of eight data beats at the SDRAM. This means at least two write commands when using SDRAM burst length of 4.
4. Start with byte 0 (i.e. byte 0 is selected for training).
5. Disable all the other bytes except the byte that has been selected for training. Bytes are enabled/disabled by writing 1/0 to DXnDGCR.DXEN.
6. Start with the selected rank byte DQS gating system latency (DXnDQSTR.RnDGSL) of 0.
7. Start with the selected rank byte DQS gating phase select

(DXnDQSTR.RnDGPS) of 0.

8. Write the selected DQS gating configurations (RnDGSL and RnDGPS) to DXnDQSTR register of the selected byte, making sure the fields for the unselected ranks remain unchanged.

9. Execute reads from the SDRAM locations previously written. The number of reads must be equal to the number of writes used in Step 3. Compare the read data with the expected (written) data and log the pass/fail status as a sequence or history of flags for each trained RnDGSL/RnDGPS configuration (e.g. FFPPPPPFF). A fail is either when there is a data miscompare or when fewer data than expected is returned. Note that a controller that is designed to always wait for the correct number of read data may need a time-out in case the trained configuration results in fewer data than expected. This is not an issue when using the PUB DCU because it does not wait for the expected number of reads; rather the read count status will indicate if fewer reads were returned.

10. Once the read data has been compared and the pass/fail status logged, issue an ITM soft reset to clear the status of the read data logic in the PHY. This is important because the ITM read data FIFO pointers may be in the wrong state at the end of training an RnDGSL/RnDGPS configuration that resulted in wrong DQS gating window.

11. If two consecutive fails and some passes exist, then this is the end of the training for this rank byte. In this case, do the following:

- Select the middle of the passes and write the values to the corresponding fields of DXnDQSTR register, making sure the fields for the unselected ranks remain unchanged
- If this is not the last byte, then select the next byte and go to Step 5
- If this is the last byte but not the last rank, then select the next rank and go to Step 3
- If this is the last byte and the last rank, then go to Step 12 to do final clean-up before the end of the DQS gate training.
- If the condition of two consecutive fails and some passes does not exist, then this signals that more RnDGSL/RnDGPS configurations need to be trained for this rank byte. If this is the case, do the following:
 - if RnDGPS is less than 3, then increment RnDGPS and go to Step 8
 - if RnDGPS is equal to 3 but RnDGSL is less than 7, then increment RnDGSL and go to Step 7
 - if RnDGPS is equal to 3 and RnDGSL is equal to 7, then log an error because this is a signal that something in the system is very wrong such that no passing configuration is possible for this rank byte. With such an error condition, you can either terminate the whole training to investigate the system or you can go to train the next byte.

12. Once the training of all ranks and all bytes is finished, issue one or more dummy reads to the same SDRAM locations. This will flush out the DQS drift compensation logic in the PHY and therefore avoid reporting any false drift events caused by previous DQS gating settings.

13. Once the dummy reads have completed, re-enable drift compensation by writing 1 to PGCR.DFTCMP register. This is the end of DQS gate training. Regular memory operations can now commence.

13.8.5 Impedance Calibration

The impedance calibration circuit, which controls the impedance values for ODT and driver output impedance, consists of the following components:

- ✧ ZQ calibration cell - PZQ
- ✧ External RZQ precision resistor
- ✧ Impedance control logic - zctrl

- ✧ VREF cell (for code encoding and level shifting)
- ✧ Functional I/O cells

The connectivity of these components is shown as follow figure:

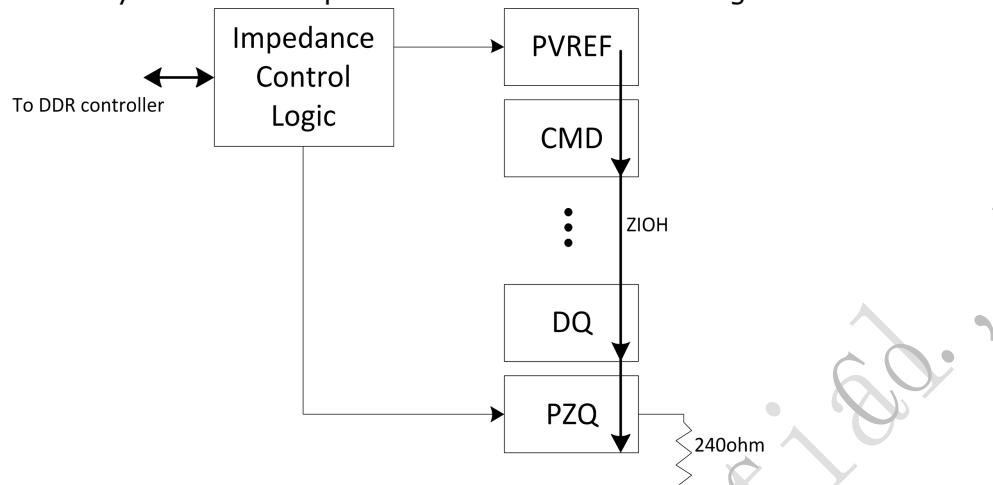


Fig. 13-17 Impedance Calibration Circuit

A single calibration cell (PZQ) is used for the interface. The user connects the PZQ pin through an external $240\text{ohm} \pm 1\%$ resistor to ground. One or multiple VREF cells exist in the interface, depending on the total data width of the interface. The ZCTRL bus from the impedance control logic is connected to all VREF cells in the interface. It is not permitted to have a VREF cell in the interface that is not connected to the impedance control logic.

The impedance control logic sends an impedance code through the ZCTRL bus to the VREF cells. The VREF cells encode this data, level shifts it to the VDDQ power domain, and sends it to both the functional I/O cells and the PZQ cell through the ZIOH bus embedded within the SSTL cells. The PZQ cell also receives the desired divide ratios from the Memory Controller or the user logic. The PZQ cell compares the impedance control code received from the PVREF cell with the external resistor, taking into account the selected divide ratio. The PZQ cell then sends ZCOMP back to the impedance control logic to relay information about impedance matching. The impedance control logic then sends a new impedance code to the PVREF cells. This results in a closed-loop system.

The four impedance elements are calibrated sequentially:

- ✧ Pull-up termination impedance
- ✧ Pull-down termination impedance
- ✧ Pull-up output impedance
- ✧ Pull-down output impedance

The ZPROG bus is used to signal which element is being calibrated. The state machine is implemented on the Impedance Controller RTL block.

The impedance control logic connects to the Memory Controller or customer logic to allow full controllability and observability of the loop operation.

The impedance control loop operates with a low bandwidth as compared to the memory system, thus the impedance control logic contains a clock divider to permit operation at a reduced clock frequency.

There are three basic modes of operation:

- ✧ Direct Calibration -uses ZPROG settings.
- ✧ Override Setting - uses ctrl_ovrd_data settings.
- ✧ Custom Calibration - extends calibration beyond the values available on ZPROG

Direct Calibration

In this mode, the user is setting independently the value for ODT (ZPROG[7:4]) and Output Impedance (ZPROG[3:0]) and runs the calibration sequence:

1. Output impedance pulldown
2. Output impedance pull-up
3. On-Die termination (ODT) pull-down
4. ODT pull-up

Override Setting

In this mode, the user is not using the calibration loop, and instead directly controls the impedance control using zctrl_ovrd_data[19:0] bus, which is parsed in four nibbles that independently control driver pull-down/up and ODT pull-down/up impedance in 31 steps.

For example, assuming one step is associated to current I and the calibration voltage is VREF, the programmed impedance for index N is:

$$ZPROG = K * VREF/(N * I)$$

K is correction factor, which is approximately equal to 1. Based on the formula, it can be concluded that if index N is increased, then the impedance is decreased.

Custom Calibration

This mode is a two-step procedure combining the previous two modes.

1. The user provides a Direct Calibration using a convenient value and records the Impedance control results from status register.

2. The user applies the correction factor that provides the custom impedance.

The following example assumes that it is required to program Driver Output Impedance to 18 ohms.

1. The user performs a Direct Calibration for driver $Z_o=36$ ohms. For example, assume the result shows that Driver pull-up index is 12, and Driver pull-down index is 13.

2. Calculate and apply the Override Data for 18 ohm impedance adjustment as follows:

$$(<\text{cal_value}>/<\text{req_value}>) * <\text{cal_index}>$$

$$\text{Driver pull-down } (36/18) * 13 = 26$$

$$\text{Driver pull-up } (36/18) * 12 = 24$$

13.8.6 Retention Functional

The purpose of the retention function is to retain a known state on the signals to the SDRAMs while the system is placed in a low power mode, specifically when the core VDD supply is powered down. The general concept is that an external input signal (RET_EN) is driven low to put the SSTL I/O cells into retention mode shortly before the core VDD supply is powered down. The user must set the SSTL I/O outputs in the state required during power down before asserting RET_EN. This ensures that the output state of all SSTL I/Os are held static in the desired state while core VDD is power down. After core VDD is restored, the user must re-initialize the core logic to a known state before de-asserting the RET_EN signal.

Following figure provides the I/O cell arrangement with retention.

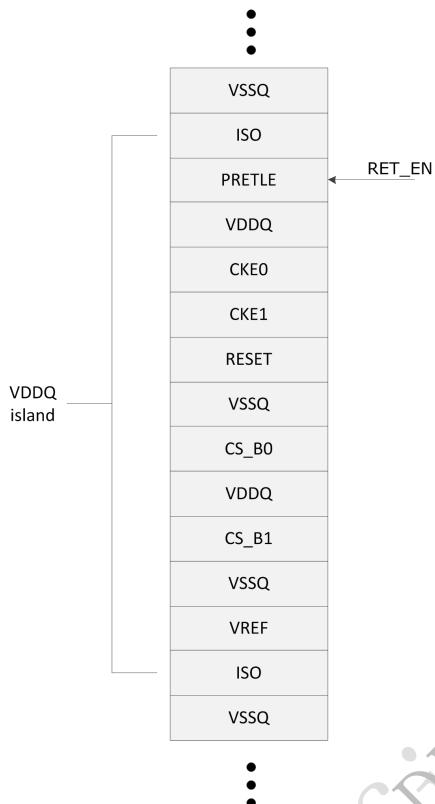


Fig. 13- 18I/O cell arrangement with retention

IOs between two ISO is a VDDQ island, they will maintain power on when other IOs are powered down by RET_EN active.

Following figure provides a sequence of events to enter and exit retention.

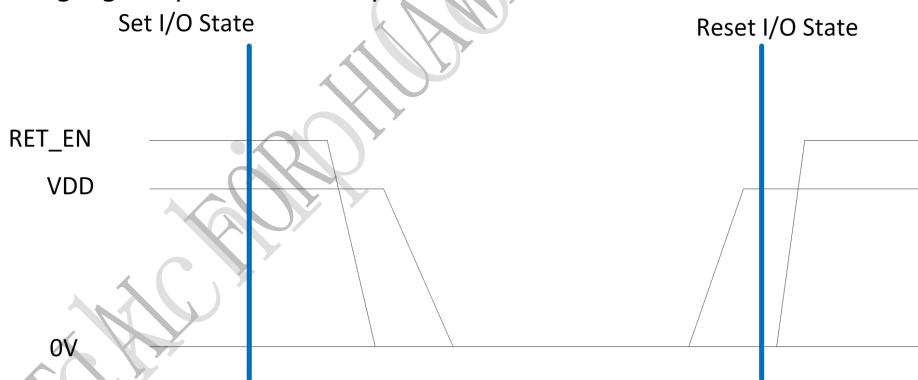


Fig. 13- 19 Sequence of Events to Enter and Exit Retention

CKE Retention Mode

An alternative CKE retention mode is supported. This scheme works by placing the SDRAMs into self-refresh mode and then driving the CKE signal low. Core VDD and VDDQ can then both be powered down except for a small VDDQ island supplying the CKE output cell. Two of the special 5um spacer cells ISO are used to break the VDDQ rail in order to create a separate CKE VDDQ island, which is kept powered while core VDD and the main VDDQ are powered down.

The sequence of events is as follows:

1. Enter self-refresh mode using the Self-Refresh Command
2. Set CKE low
3. Stop CK/CKB
4. Assert RET_EN (low)
5. Power-Off
6. Power-On

7. After reset is released, execute initialization
8. De-assert RET_EN (high)
9. Start CK/CKB
10. Set CKE high
11. Exit self-refresh mode

13.8.7 Low Power Operation

Low_power state can be entered/exited via following ways:

- Software control of PCTL State machine (highest priority)
- Hardware Low Power Interface (middle priority)
- Auto Self Refresh feature (lowest priority)

Note the priority of requests from Access to Low_power is highlighted above. The STAT.ip_trig register field reports which of the 3 requests caused the entry to Low_power state.

Software control of PCTL State

The application can request via software to enter the memories into Self Refresh state by issuing the SLEEP command by programming SCTL.PCTL responds to the software request by moving into the Low_power operational state and issuing the SRE command to the memories. Note that the Low_power state can only be reached from the Access state.

In a similar fashion, the application requests to exit the memories from Self Refresh by issuing a WAKEUP command by programming SCTL.. PCTL responds to the WAKEUP command issuing SRX and restoring normal NIF address channel operation.

Hardware Low Power Interface

The hardware low power interface can also be used to enter/exit Self Refresh. The functionality is enabled by setting SCFG.hw_low_power_en=1. Once that bit is set, the input c_sysreq has the ability to trigger entry into the

Low Power configuration state just like the software methodology (SCTL.state_cmd=SLEEP). A hardware Low Power entry trigger will be ignored/denied if the input c_active_in=1 or n_valid=1. It may be accepted if c_active_in=0 and n_valid=0, depending on the current state of the PCTL. When SCFG.hw_low_power_en=1, the outputs c_sysack and c_active provide feedback as required by the AXI low power interface specification (this interface's operation is defined by the AXI specification). c_sysack acknowledges the request to go into the Low_power state, and c_active indicates when the PCTL is actually in the Low_power state.

The c_active output could also be used by an external Low Power controller to decide when to request a transition to low power. When MCFG1.hw_idle > 0, c_active = 1'b0 indicates that the NIF has been idle for at least MCFG1.hw_idle * 32 * n_clk cycles while in the Access state.

When in low power the c_active output can be used by an external Low Power controller to trigger a low power exit. c_active will be driven high when either c_active_in or n_valid are high. The path from c_active_in and n_valid to c_active is asynchronous so even if the clocks have been removed c_active will assert. The Low Power controller should re-enable the clocks when c_active is driven high while in the Low_power state.

Auto Clock Stop/Power Down/Self Refresh

The Clock Stop and/or Power Down and/or Self Refresh sequence is automatically started by PCTL when the NIF address channel is idle for a number

of cycles, depending on the programmed value in MCFG.mddr_lpddr2_clkstop_idle and MCFG.pd_idle and MCFG1.sr_idle. Following table outlines the effect of these settings in conjunction with NIF being idle.

mddr_lpddr2_clkstop_idle	pd_idle	sr_idle	Memory modes	Memory Type
0	0	0	none	All
>0	0	0	Clock Stop	mDDR/LPDDR2 only
0	>0	0	Power Down	All
>0	>0	0	Clock Stop -> Power Down ¹	mDDR/LPDDR2 only
0	0	>0	Self Refresh	All
>0	0	>0	Clock Stop -> Self Refresh ²	mDDR/LPDDR2 only
0	>0	>0	Power Down -> Self Refresh ³	All
>0	>0	>0	Clock Stop -> Power Down -> Self Refresh ⁴	mDDR/LPDDR2 only

Note:

1. *Clock Stop is entered if NIF is idle for mddr_lpddr2_clkstop_idle. Following on from that, if NIF continues to be idle for a further pd_idle cycles, Clock Stop is exited and Power Down is entered.*

2. *Clock Stop is entered if NIF is idle for mddr_lpddr2_clkstop_idle. Following on from that, if NIF continues to be idle for a further sr_idle*32 cycles, Clock Stop is exited and Self Refresh is entered.*

3. *Power Down is entered if NIF is idle for pd_idle. Following on from that, if NIF continues to be idle for a further sr_idle*32 cycles, Power Down is exited and Self Refresh is entered.*

4. *Clock Stop is entered if NIF is idle for mddr_lpddr2_clkstop_idle. Following on from that, if NIF continues to be idle for a further pd_idle cycles, Clock Stop is exited and Power Down is entered. Following on from that, if NIF continues to be idle for a further sr_idle*32 cycles, Power Down is exited and Self Refresh is entered.*

Removing PCTL's n_clk

In LPDDR2 and DDR3, the relationship between SRE/SRX and stopping/starting the memory clock (CK) are formalized and are accounted for automatically by PCTL. With LPDDR2 and DDR3, CK should only be stopped after PCTL has reached the Low_power state. The current operational state can be verified by reading STAT.ctl_stat. The CK must be started and stable before the Software or Hardware Low Power Interface attempts to take the memory out of Self Refresh.

PCTL's n_clk can be safely removed when PCTL is in Low Power state. The sequences outlined in Table P2-17 or Table P2-18 should be followed for safe operation:

Step	Application	PCTL
1	Write SLEEP to SCTL.state_cmd and poll STAT.ctl_stat = LOW_POWER.	Tells PCTL to move memories into Self Refresh and waits until this completes.
2	Write TREFI=0. Also, write DFITCRLUPDI=0 and DFIREFMSKI=0, if they are not already 0.	Stops any MC-driven DFI updates occurring internally with PCTL
3	Wait a minimum interval which is equivalent to the PCTL's Refresh Interval (previous value of TREFI*TOGCNT100N*internal timers clock period;	Ensures any already scheduled PHY/PVT updates have completed successfully.
4	Stop toggling n_clk to PCTL.	n_clk logic inside PCTL is stopped.
end		

Step	Application	PCTL
1	Drive c_active_in low	Confirms that system external to PCTL can accept a Low-power request
2	Drive c_sysreq low	System Low-power request
3	Wait for PCTL to drive c_sysack low	PCTL Low-power request acknowledgement
4	Check value of c_active when Step 3 occurs. - if c_active=1, request denied. Cannot remove n_clk. Go to END. - if c_active=0, request accepted.	PCTL low-power request status response
5	Stop toggling n_clk to PCTL	n_clk logic inside PCTL is stopped
end		

Deep Power-Down

Compared with DDR2/DDR3, mDDR and LPDDR2 has an additional low power mode (Deep Power Down). :

- ❖ Software-driven Deep Power Down Entry – on reception of DPDE from the application, PCTL drives CKE low for TDPD.t_dpd. After TDPD, MCMD.start_cmd will be cleared to 1'b0. The following are recommended values for TDPD:
 - ◆ mDDR: TDPD=0
 - ◆ LPDDR2: dependent on if the system wants to immediately power off the PCTL after Deep Power down is entered:::
 - ❖ If PCTL not Powered off: TDPD=500μs
 - ❖ Else if PCTL is Poweredoff: TDPD=0 - up to higher level system to meet tDPD requirement.
 - ❖ To Exit Deep Power Mode, full initialization of the memories must be performed.

13.8.8 PHY Power Down

The PHYCTL includes several registers for putting certain components of the PHY in power down mode. The PHTCTL also supports DFI-initiated power-down of its components using the DFI low-power protocol.

Several components of the PHY can be powered down using PHYCTL registers. There are separate power-down register bits for the address/command lane and for each byte lane. Also there are separate controls for powering down the I/Os versus powering down the DLL. Following table describes the registers that are used to power down various components of the PHY.

Register Name	Bit Field	Description
PIR	DLLBYP	Bypasses, and hence disables or powers down all PHY DLLs.
ACDLLCR	DLLDIS	Disables (powers down) the address/command lane DLL
ACIOCR	*PDD	Powers down the output drivers for address/command lane signal I/Os. Different groups of signals have dedicated driver power-down control registers to allow finer selection of signals to power down, especially that some signals, such as CKE and RST#, are required to remain powered up when the SDRAM is in self-refresh mode. Each rank CS# signal and each CK/CK# pair has dedicated driver power down control registers, with the other rank-specific

		signals (CKE and ODT) of each rank being controlled by separate power down control registers in a separate PUB register (DSGCR). There is also a dedicated driver power down control register for SDRAM reset signal. However, the rest of the signals going to the SDRAM (address, bank address, RAS#, CAS#, WE#, and PAR_IN) share a common driver power down register just dedicated for this group. The LPDDR TPD signal has a dedicated output driver power down control register in a separate PUB register (DSGCR).
ACIOCR	*PDR	Powers down the input receivers for address/command lane signal I/Os. Different groups of signals have dedicated receiver power-down control registers to allow finer selection of signals to power down. Each rank and each CK/CK# pair has dedicated receiver power down control register, with all rank-specific signals (CKE, ODT, and CS#) of each rank sharing a common, but rank-specific, receiver power down control register. There is also a dedicated receiver power down control register for SDRAM reset pins. However, the rest of the signals going to the SDRAM (address, bank address, RAS#, CAS#, WE#, PAR_IN, TPD) share a common receiver power down register just dedicated for this group.
DXCCR	DXPDD	Powers down the output drivers for DQ, DM, and DQS/DQS# signal I/Os of all byte lanes. This is a convenient way of powering down the output drivers of all byte lane I/Os with just a single register write. In addition to this, each byte has a dedicated output driver power-down register control to allow only selected bytes to be powered down.
DXCCR	DXPDR	Powers down the input receivers for DQ, DM, and DQS/DQS# signal I/Os of all byte lanes. It also powers down the PDQSR cells of all bytes. This is a convenient way of powering down the input receivers of all byte lane I/Os with just a single register write. In addition to this, each byte has a dedicated input receiver power-down register control to allow only selected bytes to be powered down.
DSGCR	CKEPDD	Powers down the output drivers for CKE I/Os. Each rank CKE has a dedicated driver power down control register to allow finer control of CKE I/O driver power-down, especially that the CKE I/O driver of an SDRAM that is in self refresh is required to remain powered up.
DSGCR	ODTPDD	Powers down the output drivers for ODT I/Os. Each rank ODT has a dedicated driver power down control register to allow finer control of ODT I/O driver power-down, especially that the ODT I/O driver of an SDRAM that is in self refresh or power down mode may be required in certain DDR modes to remain powered up.
DSGCR	TPDPD	Powers down the output driver for the optional LPDDR TPD signal I/O.
DSGCR	NL2PD	Powers down the output driver and the input receiver on the I/O for non-LPDDR2 signals (ODT, RAS#, CAS#, WE#, and BA). This may be used when a chip that is designed for both LPDDR2 and other DDR modes is being used in LPDDR2 mode, in which case one may want to power down the unused I/Os. This power down control register is in addition to (ORed with) the individual ACIOCR power down control registers for these signals.
ZQnCR0	ZQPD	Powers down the PZQ cell. Each PZQ has a dedicated power down control register.
DXnDLLCR	DLLDIS	Disables (powers down) the byte lane DLL. Each byte lane has a dedicated DLL power down control register.
DXnGCR	DXPDD	Powers down the output drivers for DQ, DM, and DQS/DQS# signal I/Os of the byte lane. Each byte lane has a dedicated output driver power down control register, in conjunction with the global output driver power down control register DXCCR.DXPDD.

DXnGCR	DXPDR	Powers down the input receivers for DQ, DM, and DQS/DQS# signal I/Os of the byte lane. Each byte lane has a dedicated input receiver power down control register, in conjunction with the global input receiver power down control register DXCCR.DXPDR.
DXnGCR	DQSRPD	Powers down the PDQSR cells of the byte lane. Each byte lane has a dedicated PDQSR power down control register, in conjunction with the global PDQSR power down control register DXCCR.DXPDR.
PGCR	PDDISDX	Selects whether the I/Os and DLL of a disabled byte should automatically be powered down by the PUB. A byte can be disabled by writing a '0' to the DXnGCR.DXEN register or by using the DFI data byte disable (dfi_data_byte_disable) signal.
DSGCR	LPIOPD	Specifies whether the PHY should respond to the controller-initiated DFI low power opportunity request and power down the I/Os of the PHY.
DSGCR	LPDLLPD	Specifies whether the PHY should respond to the controller-initiated DFI low power opportunity request and power down the DLL of the PHY if the requested wakeup time is greater than 2048 clock cycles

DFI-Initiated Power-Down

There are two ways how the controller can initiate PHY power down through the DFI interface. The first method is when the controller asserts the DFI data byte disable (dfi_data_byte_disable) signal during initialization when the DFI initialization start (dfi_init_start) signal is high. In this state, the PHY will power down the DLL and I/Os of the selected bytes if it is configured through DSGCR.BDISEN to respond to DFI data byte disable and if disabled bytes are configured through PGCR. PDDISDX to be powered down. The DFI data byte disable feature is normally used as a static configuration to disable bytes that are not being used.

The controller can also initiate PHY power down by using the DFI low power control interface. This is a dynamic low power request-acknowledge protocol that the controller may use to put the PHY into low power mode when it is not being used for a prolonged time. The PHY will acknowledge a low power request from the controller and power down I/Os and DLLs if it is configured to do so through DSGCR.LPIOPD and DSGCR.LPDLLPD. If the low power wakeup time requested by the controller is less than 2048 clock cycles, then only the I/Os will be powered down. Otherwise if the wakeup time is equal to or more than 2048 cycles, then the DLLs and the I/Os are all powered down. If the DLLs are powered down, then on low power wakeup the PUB will soft reset the DLLs and wait for them to lock before acknowledging the low power wakeup request to the controller.

13.8.9 Dynamic ODT for I/Os

By default the DFI turns on the ODT for the PHY I/Os for DQ/DQS# only when there is read data coming back. This is called dynamic ODT control and is used to reduce power consumed by the termination resistors. The DFI uses the timing of the DQS gating to accurately place the PHY I/O ODT enable signal around the read data. Typically, the DFI turns on the byte ODT enable signal 2 clocks before the pre-amble and turns it off one clock after the post-amble. This guarantees correct setup and hold on the I/Os.

The PHY ODT signal does not go through the ITMs and therefore has to fan out to the DQ/DQS from RTL logic in the PHYCTL. This may result in different timing on these signals depending on the routing. For this reason various programmable features are provided on the ODT control signals to help mitigate some of the timing issues that may result from different

implementations. These are described in the DXnGCR register. In summary, both the starting position and the width of the enable signal can be adjusted relative to the default position and lengths.

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Chapter 14 SMC(Static Memory Controller)

14.1 Overview

The SMC is an Advanced Microcontroller Bus Architecture (AMBA) compliant System-on-Chip peripheral. It consists of high-performance, area-optimized SRAM memory controllers with on-chip bus interfaces that conform to the AMBA Advanced extensible Interface (AXI) protocol.

The SRAM memory interface type is defined as supporting asynchronous SRAM and NOR flash.

The SMC provides the following features:

- Support asynchronous SRAM and Nor Flash
- Configurable SRAM memory data widths of 8-bit or 16-bit
- AXI data width of 32-bit
- Up to two chip selects, each is up to 16MBbytes
- Programmable cycle timings per chip select.
- Support shared and separated data/address bus
- Support for a remap signal

14.2 Block Diagram

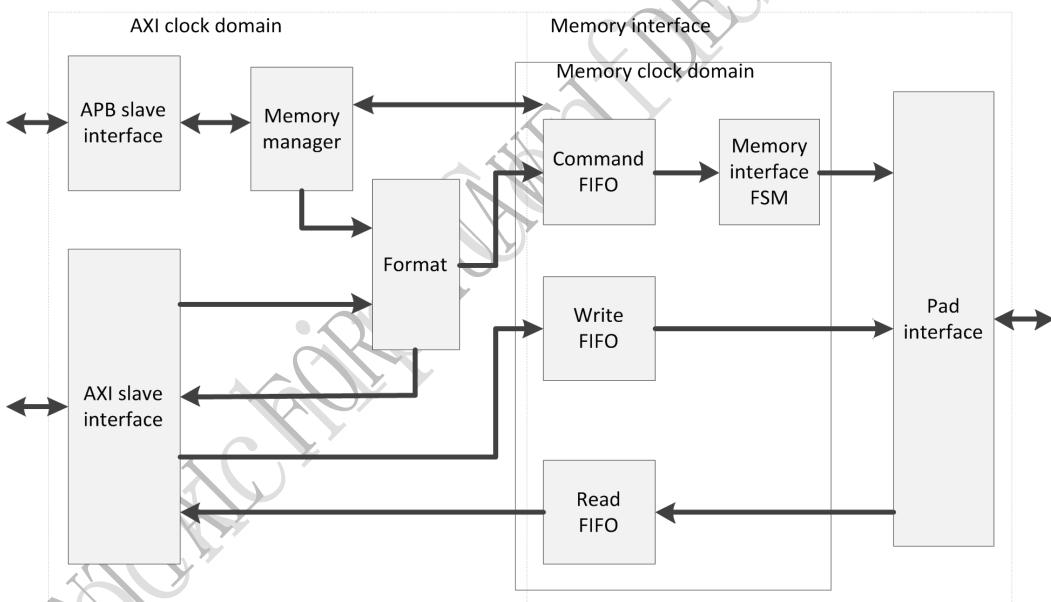


Fig. 14-1 SMC architecture diagram

14.3 Function Description

14.3.1 APB slave interface

The APB interface is a fully-compliant APB slave. The SMC has 4KB of memory allocated to it. The APB slave interface accesses the SMC registers to program the memory system configuration parameters and to provide status information.

The APB interface is clocked by the same clock as the AXI domain clock, `aclk`, but has a clock enable so that it can be slowed down to execute at an integer divisor of `aclk`.

14.3.2 Format

The format block receives memory accesses from the AXI slave interface and the memory manager. Requests from AR and AW channels are arbitrated on a round-robin basis. Requests from the manager have the highest priority. The format block also maps AXI transfers onto appropriate memory transfers and passes these to the memory interface through the command FIFO.

Hazard handling

The following types of hazard exist:

- Read after read (RAR)
- Write after write (WAW)
- Read after write (RAW)
- Write after read (WAR).

The AXI specification defines that RAW and WAR ordering is determined by the master, whereas RAR and WAW ordering is enforced by the slave. If an AXI master requires ordering between reads and writes to certain memory locations, it must wait for a write response before issuing a read from a location it has written to (RAW). It must also wait for read data before issuing a write to a location it has read from (WAR). The SMC ensures the ordering of read transfers from a single master is maintained (RAR), and additionally, that the ordering of write transfers from a single master is maintained (WAW).

RAR and WAW hazards only occur in configurations that have two memory interfaces. But we only use one memory interface, so we can ignore them.

SRAM memory accesses

A. Memory address shifting

To produce the address presented to the memory device, the AXI address is aligned to the memory width. This is done because the AXI address is a byte-aligned address, whereas the memory address is a memory-width-aligned address.

During initial configuration of a memory device, the memory mode register can be accessed with a sequence of transfers to specific addresses. You must take into consideration the shifting performance by the SMC when accessing memory mode registers.

B. Memory burst alignment

The SMC provides a programmable option for controlling the formatting of memory transfers with respect to memory burst boundaries, through the burst_align bit of the opmode registers.

When set, the burst_align bit causes memory bursts to be aligned to a memory burst boundary. This setting is intended for use with memories that use the concept of internal pages. This can be an asynchronous page mode memory, or a synchronous PSRAM. If an AXI burst crosses a memory burst boundary, the SMC partitions the AXI transfer into multiple memory bursts, terminating a memory transfer at the burst boundary. Ensure the page size is an integer multiple of the burst length, to avoid a memory burst crossing a page boundary.

When the burst_align bit is not set, the SMC ignores the memory burst boundary when mapping AXI commands onto memory commands. This setting is intended for use with devices such as NOR flash. These devices have no concept of pages.

C. Memory burst length

The SMC enables you to program the memory burst length on an individual chip basis, from length 1 to 32 beats, or a continuous burst. The length of

memory bursts are however automatically limited by the size of the read or write data FIFOs.

For read transfers, the maximum memory burst length on the memory interface is the depth of the read data FIFO. For writes, the maximum burst length is dependent on:

- the beat size of the AXI transfer, asize
- the memory data bus width, mw
- the depth of the write data FIFO depth, wfifo_depth.

The formula to determine the maximum memory write burst length is:

$$\text{Memory write burst length} = ((1 << \text{asize}) \times \text{wfifo_depth}) / (1 << \text{mw})$$

14.3.3 Memory manager

The memory manager tracks and controls the current state of the SMC aclk domain FSM. The block is responsible for Updating register values that are used in the mclk domain, and controlling direct commands issued to memory.

Chip configuration registers

The SMC provides a mechanism for synchronizing the switching of operating modes with that of the memory device.

The SMC_SET_CYCLES Register and SMC_SET_OPMODE Register act as holding registers for new operating parameters until the SMC detects the memory device has switched modes. This enables a memory device to be made to change its operating mode while still being accessed.

The manager register bank consists of all the timing parameters chip<x>_cycles, and access modes chip<x>_opmode. These are required for the SMC to correctly time any type of access to a supported memory type.

The APB registers SMC_SET_CYCLES and SMC_SET_OPMODE act as holding registers, the configuration registers within the manager are only updated if either:

- the Direct Command Register indicates only a register update is taking place
- the SMC_DIRECT_CMD Register indicates a mode register access either using the SMC_DIRECT_CMD Register or using the AXI interface and the command has completed

Direct commands

The SMC enables code to be executed from the memory while simultaneously, from the software perspective, moving the same chip to a different operating mode. This is achieved by synchronizing the update of the chip configuration registers from the holding registers with the dispatch of the memory configuration register write.

The SMC provides software mechanisms for simultaneously updating the controller and memory configuration registers.

For memories that require a sequence of read and write commands, for example, most NOR flash devices use the AXI interface, with the write data bus used to indicate when the last transfer has completed and when it is safe for the SMC to update the chip configuration registers.

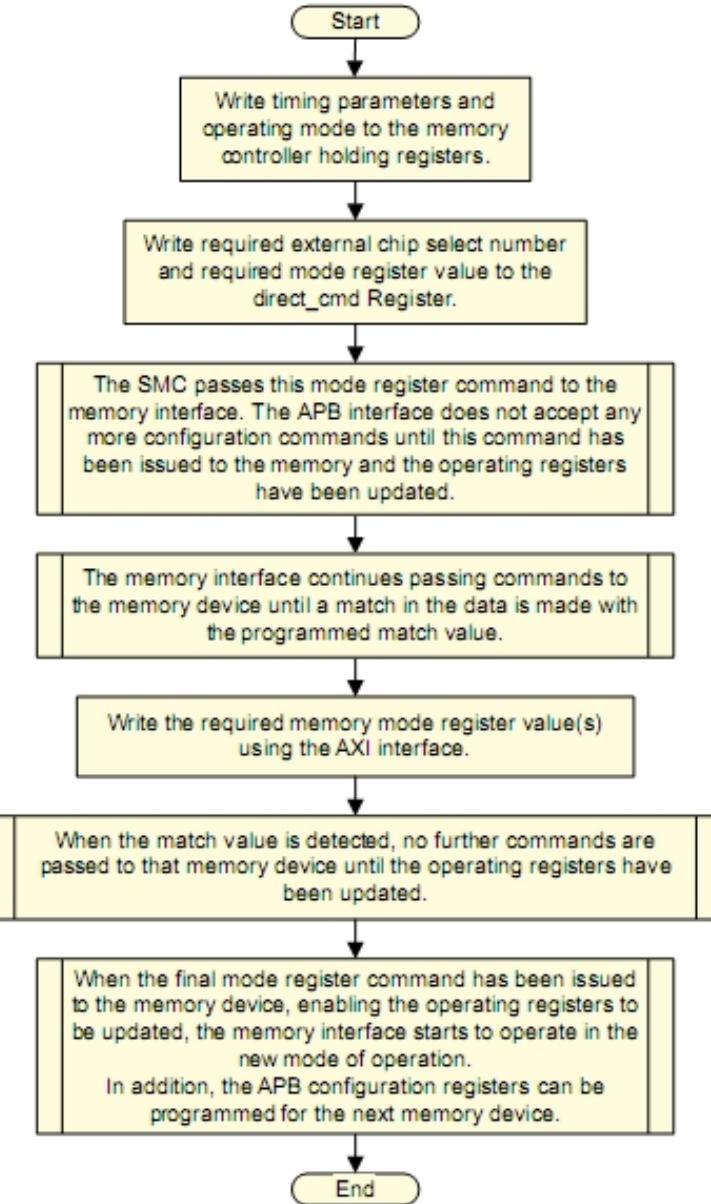


Fig. 14-2 Software Mechanism of Direct Commands in SMC

14.3.4 Memory interface

The SMC supports SRAM memory interface type, it is composed of command, read data, and write data FIFOs plus a control FSM. The memory interface FSM is specific to SRAM.

The memory interface issues commands to the memory from the command FIFO, and controls the cycle timings of these commands. It only issues a new command after the previous command is complete and any turn-around times have been met. It only issues a read command when there is space for all the impending data in the read data FIFO.

The SMC does not perform WRAP transfers on the memory interface. For memory devices that only operate in WRAP mode, you must program the SMC_SET_OPMODE Register to align transfers to a memory burst boundary. If the SMC is programmed to perform transfers that cross a memory boundary, then you must program the memory device to operate in INCR mode.

14.3.5 Pad interface

The pad interface module provides a registered I/O interface for data and control signals. It also contains interrupt generation logic.

14.3.6 SRAM interface timing diagrams

All address, control, and write data outputs of the SMC are registered on the rising edge of mclkn, equivalent to the falling edge of mclk, for asynchronous accesses.

Read data output by the memory device is also registered on the rising edge of mclkn, equivalent to the falling edge of mclk, for asynchronous reads. For asynchronous accesses, the data is then pushed onto the read data FIFO to be returned by the AXI interface.

Asynchronous read

Following figure show a single asynchronous read transfer with an initial access time, t_{RC} , of 3 cycles and an output enable assertion delay, t_{CEOE} , of one cycle.

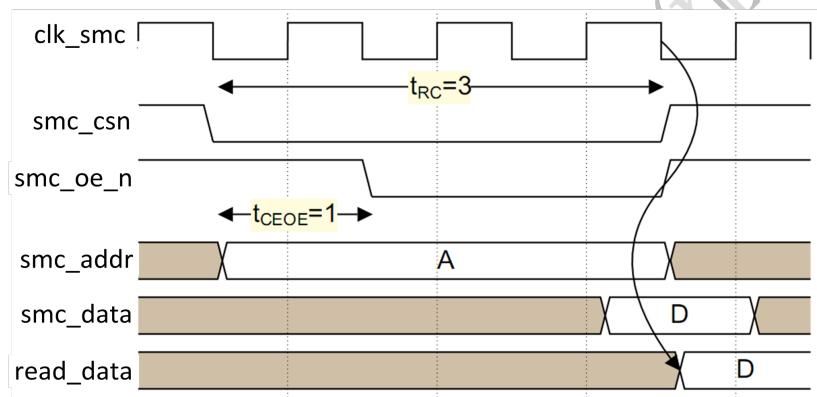


Fig. 14- 3 SMC asynchronous read timing

Asynchronous read in multiplexed mode

Following figure show a single asynchronous read transfer in multiplexed SRAM mode, with $t_{RC}=7$, and $t_{CEOE}=5$.

In multiplexed mode, both address and data are output by the SMC on the data_out bus. Read data is accepted on the data_in bus. The address is still driven onto the address bus in multiplexed mode. This enables you to use the upper address bits for memories that require more address bits than data bits.

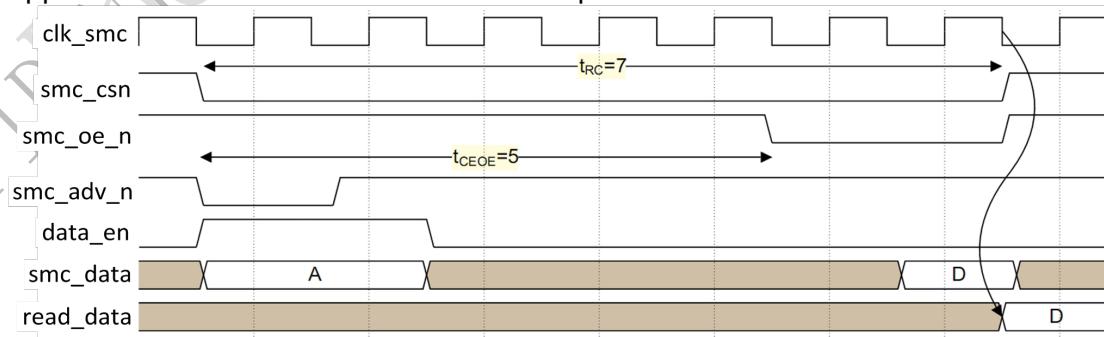


Fig. 14- 4 SMC asynchronous read timing in multiplexed mode

Asynchronous write

Following figure show a single asynchronous write with a write cycle time t_{WC}

of four cycles and a we_n assertion duration, tWP, of two cycles.

The timing parameter tWP controls the deassertion of we_n. You can use it to vary the hold time of cs_n, addr and data. This differs from the read case where the timing parameter tCEO controls the delay in the assertion of oe_n. Additionally, we_n is always asserted one cycle after cs_n to ensure the address bus is valid.

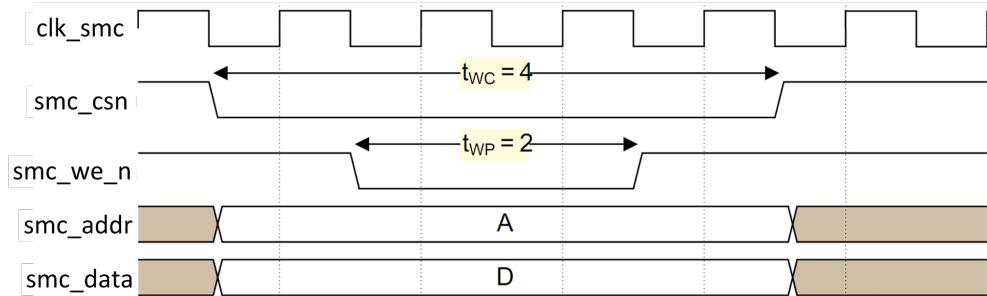


Fig. 14- 5 SMC asynchronous write timing

Asynchronous write in multiplexed mode

Following figure show a single asynchronous write in multiplexed mode when the we_time bit is 0. tWC is seven cycles, tWP is four cycles, and the we_time bit programs the assertion of we_n to occur two clock cycles after cs_n goes LOW.

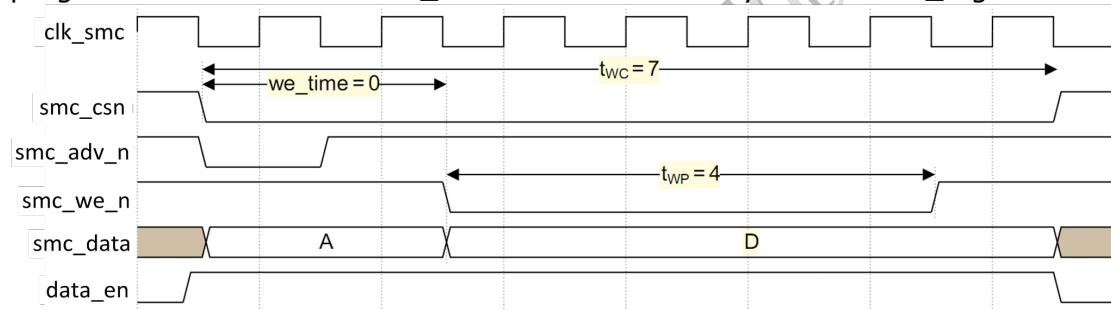


Fig. 14- 6 SMC asynchronous write timing in multiplexed mode 1

Following figure show a single asynchronous write in multiplexed mode when the we_time bit is 1. tWC is seven cycles, tWP is four cycles, and the we_time bit programs the assertion of we_n to occur when cs_n goes LOW

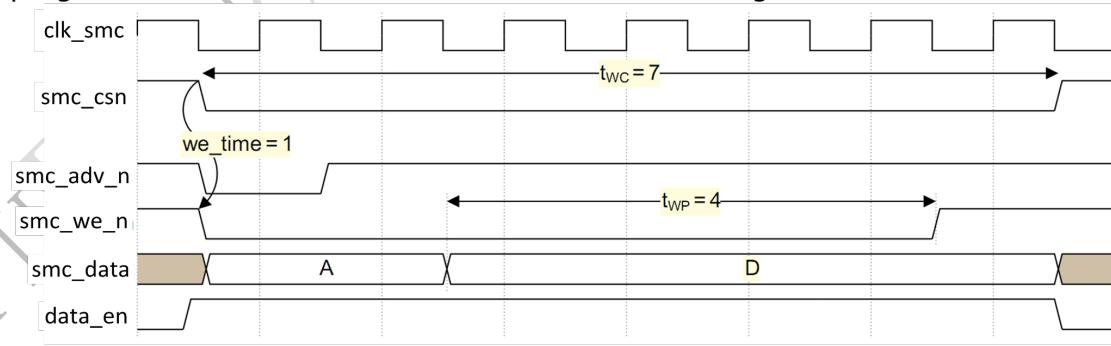


Fig. 14- 7 SMC asynchronous write timing in multiplexed mode 2

Asynchronous page mode read

Following figure show a page read access, with an initial access time, tRC, of three cycles, an output enable assertion delay, tCEO, of two cycles, and a page access time, tPC, of one cycle.

You enable Page mode in the SMC by setting the opmode Register for the

relevant chip to asynchronous reads, and the burst length to the page size. Multiplexed mode page accesses are not supported.

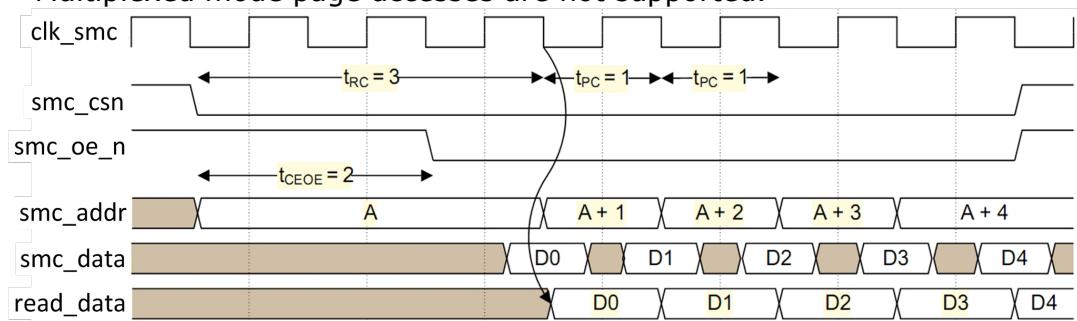


Fig. 14-8 SMC page read timing

14.4 Register Description

This section describes the control/status registers of the design.

14.4.1 Registers Summary

Name	Offset	Size	Reset Value	Description
SMC_MEMC_STATUS	0x0000	W	0x00000000	Memory Controller Status Register
SMC_MEMIF_CFG	0x0004	W	0x00000000	Memory Interface Configuration Register
SMC_MEMC_CFG_SET	0x0008	W	0x00000000	Set Configuration Register
SMC_SMC_MEMC_CFG_CLR	0x000c	W	0x00000000	Clear Configuration Register
SMC_DIRECT_CMD	0x0010	W	0x00000000	Direct Command Register
SMC_SET_CYCLES	0x0014	W	0x00000000	set_cycles Register
SMC_SET_OPMODE	0x0018	W	0x00000000	set_opmode Register
SMC_REFRESH_PERIOD0	0x0020	W	0x00000000	refresh_period_0 Register
SMC_SRAM_CYCLES0	0x0100	W	0x00000000	sram_cycles Register for CS0
SMC_OPMODE0	0x0104	W	0x00000000	opmode Register for CS0
SMC_SRAM_CYCLES1	0x0120	W	0x00000000	sram_cycles Register for CS1
SMC_OPMODE1	0x0124	W	0x00000000	opmode Register for CS1

Notes:

Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

14.4.2 Detail Register Description

SMC_MEMC_STATUS

Address: Operational Base + offset (0x0000)

Memory Controller Status Register

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5	RO	0x0	raw_int_status0 Current raw interrupt status for interface 0
4	RO	0x0	reserved
3	RO	0x0	int_status0 Current interrupt status for interface 0

Bit	Attr	Reset Value	Description
2	RO	0x0	reserved
1	RO	0x0	int_en0 Status of memory interface 0 interrupt enable state
0	RO	0x0	Operating state of the SMC: 0 = SMC is in the ready state 1 = SMC is in the low-power state.

SMC_MEMIF_CFG

Address: Operational Base + offset (0x0004)

Memory Interface Configuration Register

Bit	Attr	Reset Value	Description
31:18	RO	0x0	reserved
17:16	RO	0x0	exclusive_monitors exclusive_monitor - Returns the number of exclusive access monitor resources that are implemented in the SMC. b00 = 0 monitors b01 = 1 monitor b10 = 2 monitors b11 = 4 monitors.
15:7	RO	0x0	reserved
6	RO	0x0	remap0 remap0 - Returns the value of the remap_0 input.
5:4	RO	0x0	memory_width0 memory_width0 - Returns the maximum width of the SMC memory data bus for interface 0: b00 = 8 bits b01 = 16 bits b10 = 32 bits b11 = reserved.
3:2	RO	0x0	memory_chips0 memory_chips0 - Returns the number of different chip selects that the memory interface 0 supports: b00 = 1 chip b01 = 2 chips b10 = 3 chips b11 = 4 chips.
1:0	RO	0x0	memory_type0 memory_type0 - Returns the memory interface 0 type: b00 = reserved b01 = SRAM non-multiplexed b10 = NAND b11 = SRAM multiplexed.

SMC_MEMC_CFG_SET

Address: Operational Base + offset (0x0008)

Set Configuration Register

Bit	Attr	Reset Value	Description
31:3	RO	0x0	reserved
2	WO	0x0	low_power_req 0 = No effect 1 = Request the SMC to enter low-power state when it next becomes idle.
1	RO	0x0	reserved
0	WO	0x0	int_enable0 0 = No effect 1 = Interrupt enable, memory interface 0.

SMC_SMC_MEMC_CFG_CLR

Address: Operational Base + offset (0x000c)

Clear Configuration Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3	WO	0x0	int_clr_0 0 = No effect 1 = Clear SMC Interrupt 0 (as an alternative to an AXI read).
2	WO	0x0	low_power_exit 0 = No effect 1 = Request the SMC to exit low-power state.
1	RO	0x0	reserved
0	WO	0x0	int_disable0 0 = No effect 1 = Interrupt disable, memory interface 0.

SMC_DIRECT_CMD

Address: Operational Base + offset (0x0010)

Direct Command Register

Bit	Attr	Reset Value	Description
31:26	RO	0x0	reserved
25:23	WO	0x0	chip_select Selects chip configuration register bank to update, and enables chip mode register access depending on cmd_type. The encoding is: b000-b011 = Chip selects 1-4 on interface 0.
22:21	WO	0x0	cmd_type Selects the command type: b00 = UpdateRegs and AXI b01 = ModeReg b10 = UpdateRegs b11 = ModeReg and UpdateRegs

Bit	Attr	Reset Value	Description
20	WO	0x0	set_cre Maps to the configuration register enable signal, cre, when a ModeReg command is issued. The encoding is: 0 = cre is LOW 1 = cre is HIGH when ModeReg write occurs.
19:0	WO	0x00000	addr When cmd_type = UpdateRegs and AXI then: bits [15:0] are used to match wdata[15:0] bits [19:16] are reserved. Write as zero. When cmd_type = ModeReg or ModeReg and UpdateRegs, these bits map to the external memory address bits [19:0]. When cmd_type = UpdateRegs, these bits are reserved. Write as zero

SMC_SET_CYCLES

Address: Operational Base + offset (0x0014)
set_cycles Register

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23:20	WO	0x0	set_t6 Contains the value to be written to we_time bit of the sram_cycles Register.
19:17	WO	0x0	set_t5 Contains the value to be written to tot_tr field of the sram_cycles Register.
16:14	WO	0x0	set_t4 Contains the value to be written to tot_pc field of the sram_cycles Register.
13:11	WO	0x0	set_t3 Contains the value to be written to the t_wp field in sram_cycles Register.
10:8	WO	0x0	set_t2 Contains the value to be written to tot_ceoe field of the sram_cycles Register.
7:4	WO	0x0	set_t1 Contains the value to be written to the t_wc field in sram_cycles Register.
3:0	WO	0x0	set_t0 Contains the value to be written to the t_rc field in sram_cycles Register.

SMC_SET_OPMODE

Address: Operational Base + offset (0x0018)
set_opmode Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:13	WO	0x0	<p>set_burst_align</p> <p>Contains the value to be written to the specific SRAM chip opmode Register burst_align field. When you configure the SMC to perform synchronous transfers, these bits control if memory bursts are split on memory burst boundaries:</p> <ul style="list-style-type: none"> b000 = bursts can cross any address boundary b001 = burst split on memory burst boundary, that is, 32 beats for continuous b010 = burst split on 64 beat boundary b011 = burst split on 128 beat boundary b100 = burst split on 256 beat boundary b101-b111 = reserved.
12	WO	0x0	<p>set_bls</p> <p>Contains the value to be written to the specific SRAM chip opmode Register byte lane strobe (bls) bit. This bit affects the assertion of the byte-lane strobe outputs.</p> <p>0 = bls timing equals chip select timing. This is the default setting.</p> <p>1 = bls timing equals we_n timing. This setting is used for eight memories that have no bls_n inputs. In this case, the bls_n output of the SMC is connected to the we_n memory input.</p>
11	WO	0x0	<p>set_adv</p> <p>Contains the value to be written to the specific SRAM chip opmode Register address valid (adv) bit. The memory uses the address advance signal adv_n when set.</p>
10	WO	0x0	<p>set_baa</p> <p>Contains the value to be written to the specific SRAM chip opmode Register burst address advance (baa) bit. The memory uses the baa_n signal when set.</p>
9:7	WO	0x0	<p>set_wr_bl</p> <p>Contains the value to be written to the specific SRAM chip opmode Register wr_bl field.</p> <p>Encodes the memory burst length:</p> <ul style="list-style-type: none"> b000 = 1 beat b001 = 4 beats b010 = 8 beats b011 = 16 beats b100 = 32 beats b101 = continuous b110-b111 = reserved.
6	WO	0x0	<p>set_wr_sync</p> <p>Contains the value to be written to the specific SRAM chip opmode Register wr_sync bit.</p> <p>The memory writes are synchronous when set.</p>

Bit	Attr	Reset Value	Description
5:3	WO	0x0	<p>set_rd_bl Contains the value to be written to the specific SRAM chip opmode Register rd_bl field. Encodes the memory burst length: b000 = 1 beat b001 = 4 beats b010 = 8 beats b011 = 16 beats b100 = 32 beats b101 = continuous b110-b111 = reserved.</p>
2	WO	0x0	<p>set_rd_sync Contains the value to be written to the specific SRAM chip opmode Register rd_sync bit. Memory in sync mode when set.</p>
1:0	WO	0x0	<p>set_mw Contains the value to be written to the specific chip opmode Register memory width (mw) field. Encodes the memory data bus width: b00 = 8 bits b01 = 16 bits b10 = 32 bits b11 = reserved. You can program this to the configured width, or half that width.</p>

SMC_REFRESH_PERIOD0

Address: Operational Base + offset (0x0020)
refresh_period_0 Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved
3:0	RW	0x0	<p>period Sets the number of consecutive memory bursts that are permitted, prior to the SMC deasserting chip select to enable the PSRAM to initiate a refresh cycle. The options are: b0000 = disables the insertion of idle cycles between consecutive bursts b0001 = an idle cycle occurs after each burst b0010 = an idle cycle occurs after 2 consecutive bursts b0011 = an idle cycle occurs after 3 consecutive bursts b0100 = an idle cycle occurs after 4 consecutive bursts . . . b1111 = an idle cycle occurs after 15 consecutive bursts.</p>

SMC_SRAM_CYCLES0

Address: Operational Base + offset (0x0100)
sram_cycles Register for CS0

Bit	Attr	Reset Value	Description
31:21	RO	0x0	reserved
20	RO	0x0	we_time For asynchronous multiplexed transfers this bit controls when the SMC asserts we_n: 0 = SMC asserts we_n two mclk cycles after asserting cs_n. 1 = SMC asserts we_n and cs_n together
19:17	RO	0x0	t_tr Turnaround time for SRAM chip configurations. Minimum permitted value = 1.
16:14	RO	0x0	t_pc Page cycle time for SRAM chip configurations. Minimum permitted value = 1
13:11	RO	0x0	t_wp we_n assertion delay. Minimum permitted value = 1.
10:8	RO	0x0	t_ceoe oe_n assertion delay for SRAM chip configurations. Minimum permitted value = 1.
7:4	RO	0x0	t_wc Write cycle time. Minimum permitted value = 2.
3:0	RO	0x0	t_rc Read cycle time. Minimum permitted value = 2.

SMC_OPMODE0

Address: Operational Base + offset (0x0104)
opmode Register for CS0

Bit	Attr	Reset Value	Description
31:24	RO	0x00	address_match Returns the value of this tie-off. This is the comparison value for address bits [31:24] to determine the chip that is selected.
23:16	RO	0x00	address_mask Returns the value of this tie-off. This is the mask for address bits[31:24] to determine the chip that must be selected. A logic 1 indicates the bit is used for comparison.

Bit	Attr	Reset Value	Description
15:13	RO	0x0	<p>burst_align When you configure the SMC to perform synchronous transfers, these bits control if memory bursts are split on memory burst boundaries:</p> <ul style="list-style-type: none"> b000 = bursts can cross any address boundary b001 = burst split on memory burst boundary, that is, 32 beats for continuous b010 = burst split on 64 beat boundary b011 = burst split on 128 beat boundary b100 = burst split on 256 beat boundary b101-b111 = reserved.
12	RO	0x0	<p>bls This bit affects the assertion of the byte-lane strobe outputs: 0 = bls timing equals chip select timing. This is the default setting. 1 = bls timing equals we_n timing. This setting is used for 8-bit memories that have no bls inputs. In this case, the bls_n output of the SMC is connected to the we_n memory input.</p>
11	RO	0x0	<p>adv The memory uses the address advance signal, adv_n, when set.</p>
10	RO	0x0	<p>baa The memory uses the burst address advance signal, baa_n, when set.</p>
9:7	RO	0x0	<p>wr_bl Selects the memory burst length for writes: b000 = 1 beat b001 = 4 beats b010 = 8 beats b011 = 16 beats b100 = 32 beats b101 = continuous b110-b111 = reserved.</p>
6	RO	0x0	<p>wr_sync When set, the memory operates in write sync mode.</p>
5:3	RO	0x0	<p>rd_bl Selects the memory burst length for reads: b000 = 1 beat b001 = 4 beats b010 = 8 beats b011 = 16 beats b100 = 32 beats b101 = continuous b110-b111 = reserved.</p>
2	RO	0x0	<p>rd_sync When set, the memory operates in read sync mode.</p>

Bit	Attr	Reset Value	Description
1:0	RO	0x0	mw Selects the SMC memory data bus width: b00 = 8 bits b01 = 16 bits b10 = 32 bits b11 = reserved.

SMC_SRAM_CYCLES1

Address: Operational Base + offset (0x0120)

sram_cycles Register for CS1

Bit	Attr	Reset Value	Description
31:21	RO	0x0	reserved
20	RO	0x0	we_time For asynchronous multiplexed transfers this bit controls when the SMC asserts we_n: 0 = SMC asserts we_n two mclk cycles after asserting cs_n. 1 = SMC asserts we_n and cs_n together
19:17	RO	0x0	t_tr Turnaround time for SRAM chip configurations. Minimum permitted value = 1.
16:14	RO	0x0	t_pc Page cycle time for SRAM chip configurations. Minimum permitted value = 1
13:11	RO	0x0	t_wp we_n assertion delay. Minimum permitted value = 1.
10:8	RO	0x0	t_ceoe oe_n assertion delay for SRAM chip configurations. Minimum permitted value = 1.
7:4	RO	0x0	t_wc Write cycle time. Minimum permitted value = 2.
3:0	RO	0x0	t_rc Read cycle time. Minimum permitted value = 2.

SMC_OPMODE1

Address: Operational Base + offset (0x0124)

opmode Register for CS1

Bit	Attr	Reset Value	Description
31:24	RO	0x00	address_match Returns the value of this tie-off. This is the comparison value for address bits [31:24] to determine the chip that is selected.

Bit	Attr	Reset Value	Description
23:16	RO	0x00	address_mask Returns the value of this tie-off. This is the mask for address bits[31:24] to determine the chip that must be selected. A logic 1 indicates the bit is used for comparison.
15:13	RO	0x0	burst_align When you configure the SMC to perform synchronous transfers, these bits control if memory bursts are split on memory burst boundaries: b000 = bursts can cross any address boundary b001 = burst split on memory burst boundary, that is, 32 beats for continuous b010 = burst split on 64 beat boundary b011 = burst split on 128 beat boundary b100 = burst split on 256 beat boundary b101-b111 = reserved.
12	RO	0x0	bls This bit affects the assertion of the byte-lane strobe outputs: 0 = bls timing equals chip select timing. This is the default setting. 1 = bls timing equals we_n timing. This setting is used for 8-bit memories that have no bls inputs. In this case, the bls_n output of the SMC is connected to the we_n memory input.
11	RO	0x0	adv The memory uses the address advance signal, adv_n, when set.
10	RO	0x0	baa The memory uses the burst address advance signal, baa_n, when set.
9:7	RO	0x0	wr_bl Selects the memory burst length for writes: b000 = 1 beat b001 = 4 beats b010 = 8 beats b011 = 16 beats b100 = 32 beats b101 = continuous b110-b111 = reserved.
6	RO	0x0	wr_sync When set, the memory operates in write sync mode.
5:3	RO	0x0	rd_bl Selects the memory burst length for reads: b000 = 1 beat b001 = 4 beats b010 = 8 beats b011 = 16 beats b100 = 32 beats b101 = continuous b110-b111 = reserved.

Bit	Attr	Reset Value	Description
2	RO	0x0	rd_sync When set, the memory operates in read sync mode.
1:0	RO	0x0	mw Selects the SMC memory data bus width: b00 = 8 bits b01 = 16 bits b10 = 32 bits b11 = reserved.

Notes: Attr: **RW**- Read/writable, **RO**- read only, **WO**-write only

14.5 Timing Diagram

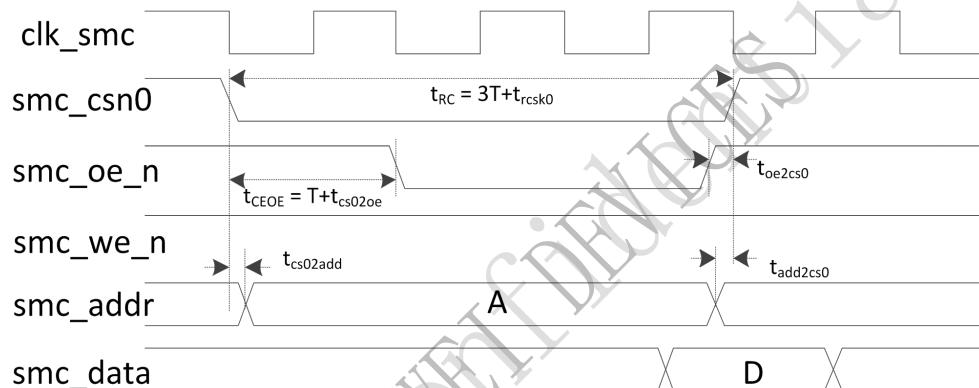


Fig. 14- 9 SMC timing diagram of asynchronous read

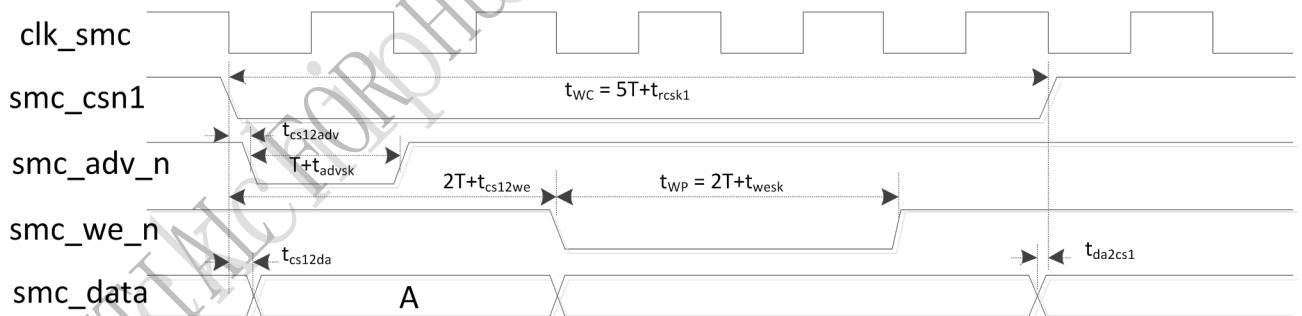


Fig. 14- 10 Asynchronous Write Timing Diagram In Multiplexed Mode

Table 14- 1 Meaning of The Parameter in Fig.14-9 and Fig.14-10

Parameter	Description	min	typ	max	unit
t _{rck0}	Rise and fall skew for smc_csn0	-4	47	872	ps
t _{rck1}	Rise and fall skew for smc_csn1	77	117	-20	ps
t _{wesk}	Rise and fall skew for smc_we_n	-27	5	22	ps
t _{cs02oe}	smc_csn0 valid to smc_oe_n valid skew	46	93	157	ps
t _{cs12oe}	smc_csn1 valid to smc_oe_n valid skew	1004	1631	2631	ps
t _{oe2cs0}	smc_oe_n invalid to smc_csn0 invalid skew	-71	-124	-189	ps
t _{oe2cs1}	smc_oe_n invalid to smc_csn1 invalid skew	-1110	-1732	-2556	ps
t _{cs02add}	smc_csn0 valid to smc_addr valid skew	3	-33	22	ps
t _{cs12add}	smc_csn1 valid to smc_addr valid skew	961	1505	2496	ps

t _{add2cs0}	smc_addr invalid to smc_csn0 invalid skew	0	-14	-109	ps
t _{add2cs1}	smc_addr invalid to smc_csn1 invalid skew	-1038	-1622	-2476	ps
t _{cs02we}	smc_csn0 valid to smc_we_n valid skew	230	347	491	ps
t _{cs12we}	smc_csn1 valid to smc_we_n valid skew	1188	1886	2966	ps
t _{advsk}	Rise and fall skew for smc_adv_n	-27	12	31	ps
t _{cs02adv}	smc_csn0 valid to smc_adv_n valid skew	-96	-79	-112	ps
t _{cs12adv}	smc_csn1 valid to smc_adv_n valid skew	861	1459	2362	ps
t _{cs02da}	smc_csn0 valid to smc_data valid skew	-166	-258	-294	ps
t _{cs12da}	smc_csn1 valid to smc_data valid skew	791	1280	2179	ps
t _{da2cs0}	smc_data invalid to smc_csn0 invalid skew	170	210	207	ps
t _{da2cs1}	smc_data invalid to smc_csn1 invalid skew	-868	-1397	-2159	ps

14.6 Interface Description

SMC IOs are multiplexed with GPIO as following Table

Table 14- 2 SMC interface mux description

ModulePin	Direction	Pad Name	IOMUX Setting
smc_oe_n	O	GPIO2_D[2]	GRF_GPIO2D_IOMUX[5:4] = 10
smc_bls_n1	O	GPIO2_D[5]	GRF_GPIO2D_IOMUX[10] = 1
smc_bls_n0	O	GPIO2_D[4]	GRF_GPIO2D_IOMUX[8] = 1
smc_we_n	O	GPIO2_D[1]	GRF_GPIO2D_IOMUX[3:2] = 10
smc_addr0	O	GPIO2_C[0]	GRF_GPIO2C_IOMUX[1:0] = 10
smc_addr1	O	GPIO2_C[1]	GRF_GPIO2C_IOMUX[3:2] = 10
smc_addr2	O	GPIO2_C[2]	GRF_GPIO2C_IOMUX[5:4] = 10
smc_addr3	O	GPIO2_C[3]	GRF_GPIO2C_IOMUX[7:6] = 10
smc_addr4	O	GPIO2_C[4]	GRF_GPIO2C_IOMUX[9:8] = 10
smc_addr5	O	GPIO2_C[5]	GRF_GPIO2C_IOMUX[11:10] = 10
smc_addr6	O	GPIO2_C[6]	GRF_GPIO2C_IOMUX[13:12] = 10
smc_addr7	O	GPIO2_C[7]	GRF_GPIO2C_IOMUX[15:14] = 10
smc_csn1	O	GPIO2_D[6]	GRF_GPIO2D_IOMUX[13:12] = 01
smc_csn0	O	GPIO2_D[0]	GRF_GPIO2D_IOMUX[1:0] = 10
smc_adv_n	O	GPIO2_D[3]	GRF_GPIO2D_IOMUX[6] = 1
smc_data0	I/O	GPIO2_A[0]	GRF_GPIO2A_IOMUX[1:0] = 10
smc_data1	I/O	GPIO2_A[1]	GRF_GPIO2A_IOMUX[3:2] = 10
smc_data2	I/O	GPIO2_A[2]	GRF_GPIO2A_IOMUX[5:4] = 10
smc_data3	I/O	GPIO2_A[3]	GRF_GPIO2A_IOMUX[7:6] = 10
smc_data4	I/O	GPIO2_A[4]	GRF_GPIO2A_IOMUX[9:8] = 10
smc_data5	I/O	GPIO2_A[5]	GRF_GPIO2A_IOMUX[11:10] = 10
smc_data6	I/O	GPIO2_A[6]	GRF_GPIO2A_IOMUX[13:12] = 10
smc_data7	I/O	GPIO2_A[7]	GRF_GPIO2A_IOMUX[15:14] = 10
smc_data8	I/O	GPIO2_B[0]	GRF_GPIO2B_IOMUX[1:0] = 10
smc_data9	I/O	GPIO4_B[1]	GRF_GPIO2B_IOMUX[3:2] = 10
smc_data10	I/O	GPIO4_B[2]	GRF_GPIO2B_IOMUX[5:4] = 10
smc_data11	I/O	GPIO4_B[3]	GRF_GPIO2B_IOMUX[7:6] = 10
smc_data12	I/O	GPIO4_B[4]	GRF_GPIO2B_IOMUX[9:8] = 10
smc_data13	I/O	GPIO4_B[5]	GRF_GPIO2B_IOMUX[11:10] = 10
smc_data14	I/O	GPIO4_B[6]	GRF_GPIO2B_IOMUX[13:12] = 10
smc_data15	I/O	GPIO4_B[7]	GRF_GPIO2B_IOMUX[15:14] = 10

14.7 Application Notes

14.7.1 multiplexed address/data mode

When SMC memory interface operates in multiplexed address/data mode, you first must config bit 6 of register GRF_SOC_CON1 in GRF(General Register Files) as 1.

In non-multiplexed mode, the SMC only support 8bit address width. In multiplexed address/data mode, smc_addr[15:0] are multiplexed with smc_data0 - smc_data15, so it can support 16bit address width and you don't need config GPIO mux of smc_addr[7:0]. If SMC has be set to 8 bits data bus width, then smc_data8 - smc_data15 and addr[7:0] don't need config GPIO mux in multiplexed address/data mode and other data and address need.

Chapter 15 NandC(Nand Flash Controller)

15.1 Overview

Nand Flash Controller (NandC) is used to control data transmission from host to flash device or from flash device to host. NandC is connected to AHB BUS through an AHB Master and an AHB Slave. The data transmission between host and external memory can be done through AHB Master Interface or AHB Slave Interface.

15.1.1 Features

- Software Interface Type
 - ◆ Support directly mode
 - ◆ Support LLP mode
- Flash Interface Type
 - ◆ Support Asynchronous Flash Interface with 8bits datawidth ("Asyn8x" for short)
 - ◆ Support Asynchronous Flash Interface with 16bits data width ("Asyn16x" for short)
 - ◆ Support ONFI Synchronous Flash Interface ("ONFI Syn" for short)
 - ◆ Support Toggle Flash Interface ("Toggle" for short)
 - ◆ Support 4 flash devices at most
- Flash Type
 - ◆ Support Managed NAND Flash(LBA) and Raw NAND Flash(NO-LBA)
 - ◆ Support SLC/MLC/TLC Flash
- Flash Interface Timing
 - ◆ Asyn8x: configurable timing, one byte per two host clocks at the fastest speed
 - ◆ Asyn16x: configurable timing, two bytes per two host clocks at the fastest speed
 - ◆ ONFI Syn: configurable timing, two bytes per two host clocks at the fastest speed
 - ◆ Toggle: configurable timing, two byte per two host clocks at the fastest speed
- Randomizer Ability
 - ◆ Support two randomizer mode with different polynomial
 - ◆ Support two randomizer width, 8bit and 16bit parallel
- BCH/ECC Ability
 - ◆ 16bit/1KB BCH/ECC: support 16bitBCH/ECC, which can detect and correct up to 16 error bits in every 1K bytes data
 - ◆ 24bit/1KB BCH/ECC: support 24bitBCH/ECC, which can detect and correct up to 24 error bits in every 1K bytes data
 - ◆ 40bit/1KB BCH/ECC: support 40bitBCH/ECC, which can detect and correct up to 40 error bits in every 1K bytes data
 - ◆ 60bit/1KB BCH/ECC: support 60bitBCH/ECC, which can detect and correct up to 60 error bits in every 1K bytes data
 - ◆ 8bit/512B BCH/ECC: support 8bitBCH/ECC, which can detect and correct up to 8 error bits in every 512 bytes data
 - ◆ 12bit/512B BCH/ECC: support 12bitBCH/ECC, which can detect and correct up to 12 error bits in every 512 bytes data
 - ◆ 20bit/512B BCH/ECC: support 20bitBCH/ECC, which can detect and correct up to 20 error bits in every 512 bytes data
 - ◆ 30bit/512B BCH/ECC: support 30bitBCH/ECC, which can detect and

- ◆ correct up to 30 error bits in every 512 bytes data
- ◆ 16bit/512B BCH/ECC: support 16bitBCH/ECC, which can detect and correct up to 16 error bits in every 512 bytes data
- ◆ 24bit/512B BCH/ECC: support 24bitBCH/ECC, which can detect and correct up to 24 error bits in every 512 bytes data
- ◆ 40bit/512B BCH/ECC: support 40bitBCH/ECC, which can detect and correct up to 40 error bits in every 512 bytes data
- ◆ 60bit/512B BCH/ECC: support 60bitBCH/ECC, which can detect and correct up to 60 error bits in every 512 bytes data
- ◆ Support auto correction for all "FF" code
- Transmission Ability
 - ◆ Support 16K bytes data transmission at a time at most
 - ◆ Support two transfer working modes: Bypass or DMA
 - ◆ Support two transfer codeword size for Managed NAND Flash: 1024 bytes/codeword or 512 bytes/codeword
- Internal Memory
 - ◆ 2 built-in srams, and the size is 1k bytes respectively
 - ◆ Can be accessed by other masters
 - ◆ Can be operated in pingpong mode by other masters

For detailed information about **NandC**, please refer to **RK3168 NandC.pdf**.

Chapter 16 eMMC Interface

16.1 Overview

The SDMMC Host Controller is designed to support Secure Digital memory (SD mem - version 3.00), Secure Digital I/O(SDIO-version 3.00), Multimedia Cards(MMC-version 4.41).The SDMMC support SD Card(1/4bit), SDIO, MMC(1/4/8bit).

Feature

- Supports AMBA AHB interface
- Supports DMA controller for data transfers
- Supports interrupt output
- Supports SD version3.0 except SPI mode
- Supports MMC version4.41 except SPI mode
- Supports SDIO version3.0
- Supports programmable baud rate.
- Provides individual clock control to selectively turn ON or OFF clock to a card
- Supports power management and power switch. Provides individual power control to selectively turn ON or OFF power to a card
- Support DDR in 4-bit mode

For detailed information about **eMMC Interface**, please refer to **RK3168 eMMC Interface.pdf**.

Chapter 17 SD/MMC Card Host Controller

17.1 Overview

The SDMMC Host Controller is designed to support Secure Digital memory (SD mem - version 3.00), Secure Digital I/O(SDIO-version 3.00), Multimedia Cards(MMC-version 4.41).The SDMMC support SD Card(1/4bit), SDIO, MMC(1/4bit).

Feature

- Supports AMBA AHB interface
- Supports DMA controller for data transfers
- Supports interrupt output
- Supports SD version3.0 except SPI mode
- Supports MMC version4.41 except SPI mode
- Supports SDIO version3.0
- Supports programmable baud rate.
- Provides individual clock control to selectively turn ON or OFF clock to a card
- Supports power management and power switch. Provides individual power control to selectively turn ON or OFF power to a card
- Support DDR in 4-bit mode

17.2 Block Diagram

The SD/MMC controller consists of the following main functional blocks, which are illustrated in Fig. 17-1.

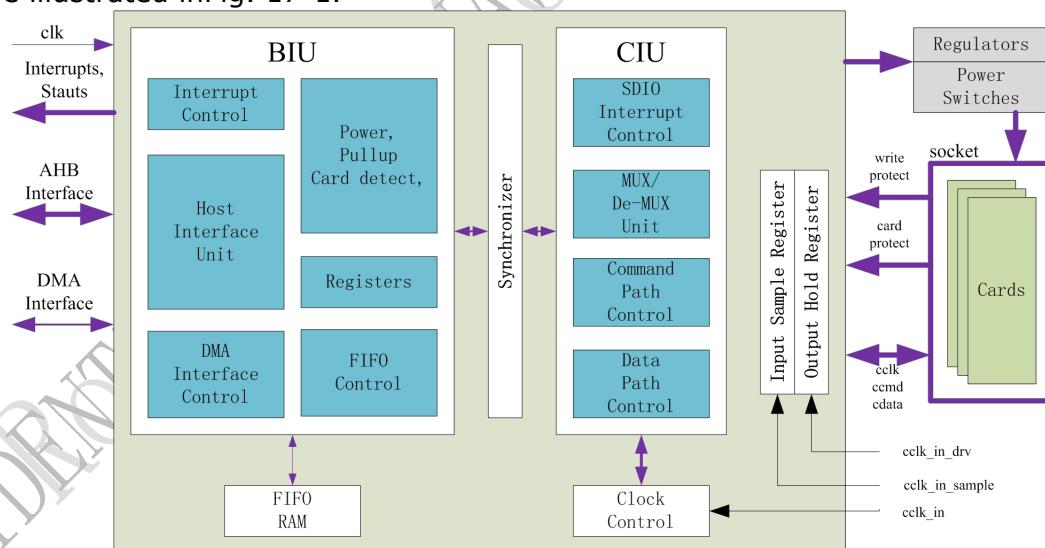


Fig. 17-1 SD/MMC Controller Block Diagram

- Bus Interface Unit (BIU) – Provides AMBA AHB and DMA interfaces for register and dataread/writes.
- Card Interface Unit (CIU) – Takes care of the SD_MMC protocols and provides clockmanagement.

17.3 Function description

17.3.1 Bus Interface Unit

The Bus Interface Unit provides the following functions:

- Host interface
- DMA interface
- Interrupt control
- Register access
- FIFO access
- Power control and card detection
- 235x32bit external fifo

Host Interface Unit

The Host Interface Unit is an AHB slave interface, which provides the interface between the SD/MMC host controller and the host bus. You can configure the host interface as either an AHB.

DMA Interface Unit

DMA signals interface the SD/MMC Host Controller to an external DMA controller to reduce the software overhead during FIFO data transfers. The DMA request/acknowledge handshake is used for only data transfers. The DMA interface provides a connection to the DMA Controller.

On seeing the DMA request, the DMA controller initiates accesses through the host interface to read or write into the data FIFO. The SD/MMC Host Controller has FIFO transmit/receive watermark registers that you can set, depending on system latency. The DMA interface asserts the request in the following cases:

- Read from a card when the data FIFO word count exceeds the Rx-Watermark level
- Write to a card when the FIFO word count is less than or equal to the Tx-Watermark level

When the DMA interface is enabled, you can use normal host read/writes to access the data FIFOs.

Register Unit

The register unit is part of the bus interface unit; it provides read and write access to the registers.

All registers reside in the Bus Interface Unit clock domain. When a command is sent to a card by setting the start_bit, which is bit[31] of the CMD register, all relevant registers needed for the CIU operation are transferred to the CIU block. During this time, the registers that are transferred from the BIU to the CIU should not be written. The software should wait for the hardware to clear the start bit before writing to these registers again. The register unit has a hardware locking feature to prevent illegal writes to registers. The lock is necessary in order to avoid metastability violations, both because the host and card clock domains are different and to prevent illegal software operations.

Once a command start is issued by setting the start_bit of the CMD register, the following registers cannot be reprogrammed until the command is accepted by the card interface unit:

- CMD – Command
- CMDARG – Command Argument
- BYTCNT – Byte Count
- BLKSIZ – Block Size
- CLKDIV – Clock Divider

- CLKENA – Clock Enable
- CLKSRC – Clock Source
- TMOUT – Timeout
- CTYPE – Card Type

The hardware resets the start_bit once the CIU accepts the command. If a host write to any of these registers is attempted during this locked time, then the write is ignored and the hardware lock error bit is set in the raw interrupt status register. Additionally, if the interrupt is enabled and not masked for a hardware lock error, then an interrupt is sent to the host.

When the Card Interface Unit is in an idle state, it typically takes the following number of clocks for the command handshake, where clk is the BIU clock and cclk_in is the CIU clock:

$$3(\text{clk}) + 3(\text{cclk_in})$$

Once a command is accepted, you can send another command to the CIU-which has a one-deep command queue-under the following conditions:

- If the previous command was not a data transfer command, the new command is sent to the SD/MMC card once the previous command completes.
- If the previous command is a data transfer command and if wait_prvdata_complete (bit[13]) of the Command register is set for the new command, the new command is sent to the SD/MMC card only when the data transfer completes.
- If the wait_prvdata_complete is 0, then the new command is sent to the SD/MMC card as soon as the previous command is sent. Typically, you should use this only to stop or abort a previous data transfer or query the card status in the middle of a data transfer.

Interrupt Controller Unit

The interrupt controller unit generates an interrupt that depends on the controller raw interrupt status, the interrupt-mask register, and the global interrupt-enable register bit. Once an interrupt condition is detected, it sets the corresponding interrupt bit in the raw interrupt status register. The raw interrupt status bit stays on until the software clears the bit by writing a 1 to the interrupt bit; a 0 leaves the bit untouched.

The interrupt port, int, is an active-high, level-sensitive interrupt. The interrupt port is active only when any bit in the raw interrupt status register is active, the corresponding interrupt mask bit is 1, and the global interrupt enable bit is 1. The interrupt port is registered in order to avoid any combinational glitches.

The following bits are available as top-level ports for debug purposes:

- Interrupt mask bits (int_mask_n[31:0])
- Raw interrupt status bits (raw_ints[31:0])
- Interrupt enable bit (int_enable)

The int_enable is reset to 0 on power-on, and the interrupt mask bits are set to 32'h0, which masks all the interrupts.

Notes: Before enabling the interrupt, it is always recommended that you write 32'hffff_ffff to the raw interrupt status register in order to clear any pending unserviced interrupts. When clearing interrupts during normal operation, ensure that you clear only the interrupt bits that you serviced.

Table 17- 1 Bits in Interrupt Status Register

Bits	Interrupt	Description
24	SDIO Interrupt	-

16	Card No busy Interrupts	If card exit busy status, the interrupt happened
15	End Bit Error (read) /Write no CRC (EBE)	Error in end-bit during read operation, or no data CRC or negative CRC received during write operation. <i>Notes: For MMC CMD19, there may be no CRC status returned by the card. Hence, EBE is set for CMD19. The application should not treat this as an error.</i>
14	Auto Command Done (ACD)	Stop/abort commands automatically sent by card unit and not initiated by host; similar to Command Done (CD) interrupt.
13	Start Bit Error (SBE)	Error in data start bit when data is read from a card. In 4-bit mode, if all data bits do not have start bit, then this error is set.
12	Hardware Locked write Error (HLE)	During hardware-lock period, write attempted to one of locked registers.
11	FIFO Underrun/Overrun Error (FRUN)	Host tried to push data when FIFO was full, or host tried to read data when FIFO was empty. Typically this should not happen, except due to error in software. Card unit never pushes data into FIFO when FIFO is full, and pop data when FIFO is empty.
10	Data Starvation by Host Timeout (HTO)	To avoid data loss, card clock out (sdmmc_clkout) is stopped if FIFO is empty when writing to card, or FIFO is full when reading from card. Whenever card clock is stopped to avoid data loss, data-starvation timeout counter is started with data-timeout value. This interrupt is set if host does not fill data into FIFO during write to card, or does not read from FIFO during read from card before timeout period. Even after timeout, card clock stays in stopped state, with CIU state machines waiting. It is responsibility of host to push or pop data into FIFO upon interrupt, which automatically restarts sdmmc_clkout and card state machines. Even if host wants to send stop/abort command, it still needs to ensure it has to push or pop FIFO so that clock starts in order for stop/abort command to send on cmd signal along with data that is sent or received on data line.
9	Data Read Timeout (DRTO)	Data timeout occurred. Data Transfer Over (DTO) also set if data timeout occurs.
8	Response Timeout (RTO)	Response timeout occurred. Command Done (CD) also set if response timeout occurs. If command involves data transfer and when response times out, no data transfer is attempted by SD/MMC Host Controller.
7	Data CRC Error (DCRC)	Received Data CRC does not match with locally-generated CRC in CIU.
6	Response CRC Error	Response CRC does not match with

	(RCRC)	locally-generated CRC in CIU.
5	Receive FIFO Data Request (RXDR)	Interrupt set during read operation from card when FIFO level is greater than Receive-Threshold level.
4	Transmit FIFO Data Request (TXDR)	Interrupt set during write operation to card when FIFO level reaches less than or equal to Transmit-Threshold level.
3	Data Transfer Over (DTO)	Data transfer completed, even if there is Start Bit Error or CRC error. This bit is also set when "read data-timeout" occurs. <i>Notes: DTO bit is set at the end of the last data block, even if the device asserts MMC busy after the last data block.</i>
2	Command Done(CD)	Command sent to card and got response from card, even if Response Error or CRC error occurs. Also set when response timeout occurs
1	Response Error (RE)	Error in received response set if one of following occurs: <ul style="list-style-type: none">● Transmission bit != 0● Command index mismatch● End-bit != 1
0	Card-Detect (CDT)	When card inserted or removed, this interrupt occurs. Software should read card-detect register (CDETECT, 0x50) to determine current card status.

FIFO Controller Unit

The FIFO controller interfaces the external FIFO to the host/DMA interface and the card controller unit. When FIFO overrun and underrun conditions occur, the card clock stops in order to avoid data loss.

The FIFO uses a two-clock synchronous read and synchronous write dual-port RAM. One of the ports is connected to the host clock, clk, and the second port is connected to the card clock, cclk_in.

Notes: The FIFO controller does not support simultaneous read/write access from the same port. For debugging purposes, the software may try to write into the FIFO and read back the data; results are indeterminate, since the design does not support read/write access from the same port.

Power Control and Card Detection Unit

The register unit has registers that control the power and MMC open-drain pullup. Power to each card can be selectively turned on or off.

The card detection unit looks for any changes in the card-detect signals for card insertion or card removal. It filters out the debounces associated with mechanical insertion or removal, and generates one interrupt to the host. You can program the debounce filter value.

On power-on, the controller should read in the card_detect port and store the value in the memory. Upon receiving a card-detect interrupt, it should again read the card_detect port and XOR with the previous card-detect status to find out which card has interrupted. If more than one card is simultaneously removed or inserted, there is only one card-detect interrupt; the XOR value indicates which cards have been disturbed. The memory should be updated with the new card-detect value.

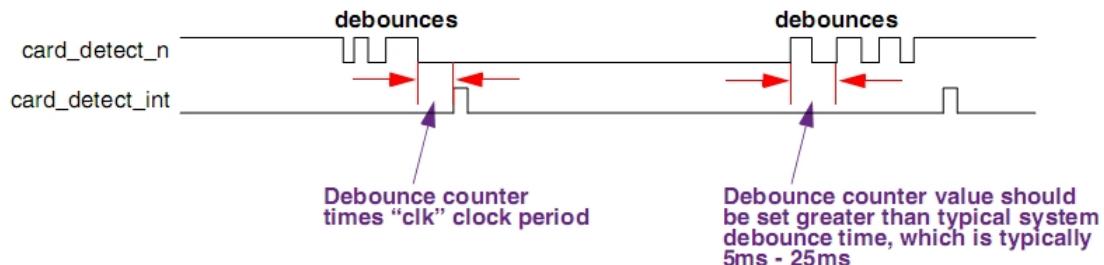


Fig. 17- 2SD/MMC Card-Detect Signal

17.3.2 Card Interface Unit

The Card Interface Unit interfaces (CIU) with the Bus Interface Unit (BIU) and the SD/MMC cards or devices. The host writes command parameters to the SD/MMC Host Controller BIU control registers, and these parameters are then passed to the CIU. Depending on control register values, the CIU generates SD/MMC command and data traffic on a selected card bus according to SD/MMC protocol. The SD/MMC Host Controller accordingly controls the command and data path.

The following software restrictions should be met for proper CIU operation:

- Only one data transfer command can be issued at a time.
- During an open-ended card write operation, if the card clock is stopped because the FIFO is empty, the software must first fill the data into the FIFO and start the card clock. It can then issue only a stop/abort command to the card.
- During an SDIO card transfer, if the card function is suspended and the software wants to resume the suspended transfer, it must first reset the FIFO and start the resume command as if it were a new data transfer command.
- When issuing card reset commands (CMD0, CMD15 or CMD52_reset) while a card data transfer is in progress, the software must set the stop_abort_cmd bit in the Command register so that the SD/MMC Host Controller can stop the data transfer after issuing the card reset command.
- When the data end bit error is set in the RINTSTS register, the SD/MMC Host Controller does not guarantee SDIO interrupts. The software should ignore the SDIO interrupts and issue the stop/abort command to the card, so that the card stops sending the read data.
- If the card clock is stopped because the FIFO is full during a card read, the software should read at least two FIFO locations to start the card clock.

The CIU block consists of the following primary functional blocks:

- Command path
- Data path
- SDIO interrupt control
- Clock control
- Mux/demux unit

1. Command Path

The command path performs the following functions:

- Loads clock parameters
- Loads card command parameters
- Sends commands to card bus (ccmd_out line)
- Receives responses from card bus (ccmd_in line)
- Sends responses to BIU
- Drives the P-bit on command line

A new command is issued to the SD/MMC Host Controller by programming the BIU registers and setting the start_cmd bit in the Command register. The BIU asserts start_cmd, which indicates that a new command is issued to the SD/MMC Host Controller. The command path loads this new command (command, command argument, timeout) and sends an acknowledge to the BIU by asserting cmd_taken.

Once the new command is loaded, the command path state machine sends a command to the SD_MMC bus—including the internally generated CRC7—and receives a response, if any. The state machine then sends the received response and signals to the BIU that the command is done, and then waits for eight clocks before loading a new command.

Load Command Parameters

One of the following commands or responses is loaded in the command path:

- New command from BIU – When start_cmd is asserted, then the start_cmd bit is set in the Command register.
- Internally-generated auto-stop command – When the data path ends, the stop command request is loaded.
- IRQ response with RCA 0x000 – When the command path is waiting for an IRQ response from the MMC card and a “send irq response” request is signaled by the BIU, then the send_irq_response bit is set in the control register.

Loading a new command from the BIU in the command path depends on the following Command register bit settings:

- update_clock_registers_only – If this bit is set in the Command register, the command path updates only the clock enable, clock divider, and clock source registers. If this bit is not set, the command path loads the command, command argument, and timeout registers; it then starts processing the new command.
- wait_prvdata_complete – If this bit is set, the command path loads the new command under one of the following conditions:
 - ◆ Immediately, if the data path is free (that is, there is no data transfer in progress), or if an open-ended data transfer is in progress (byte_count = 0).
 - ◆ After completion of the current data transfer, if a predefined data transfer is in progress.

Send Command and Receive Response

Once a new command is loaded in the command path – update_clock_registers_only bit is unset – the command path state machine sends out a command on the SD_MMC bus; the command path state machine is illustrated in Fig.17-3.

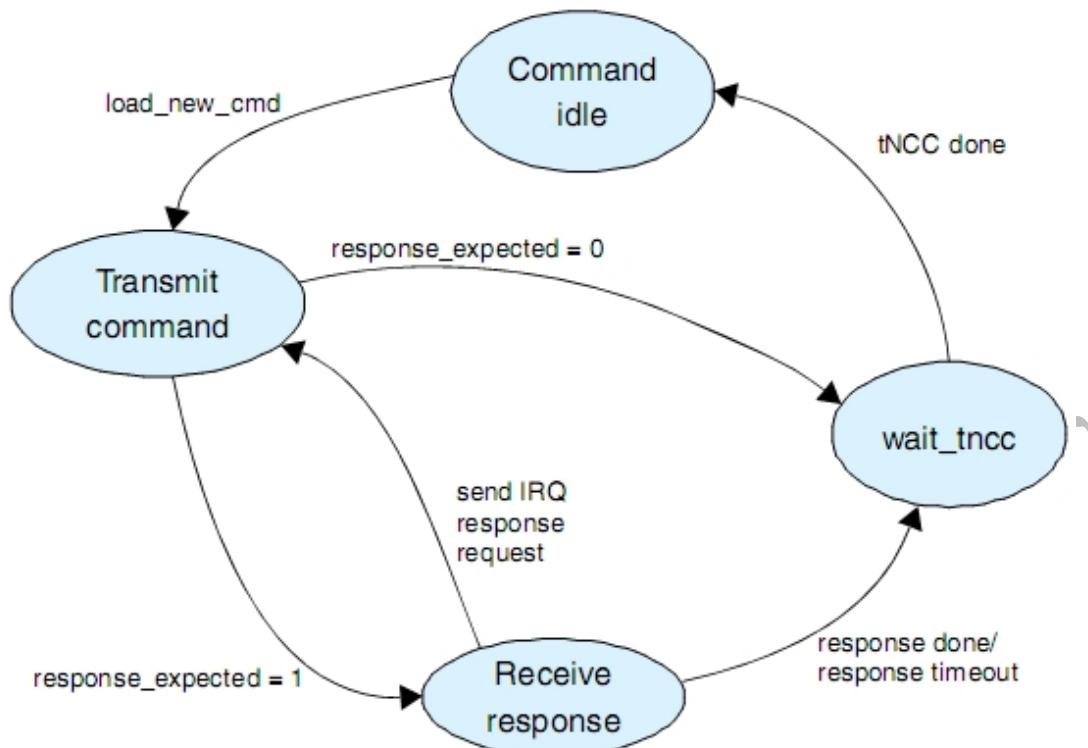


Fig. 17- 3 SD/MMC Command Path State Machine

The command path state machine performs the following functions, according to Command register bit values:

- A. send_initialization – Initialization sequence of 80 clocks is sent before sending the command.
- B. response_expected – Response is expected for the command. After the command is sent out, the command path state machine receives a 48-bit or 136-bit response and sends it to the BIU. If the start bit of the card response is not received within the number of clocks programmed in the timeout register, then the response timeout and command done bit is set in the Raw Interrupt Status register as a signal to the BIU. If the response-expected bit is not set, the command path sends out a command and signals a response done to the BIU; that is, the command done bit is set in the Raw Interrupt Status register.
- C. response_length – If this bit is set, a 136-bit response is received; if it is not set, a 48-bit response is received.
- D. check_response_crc – If this bit is set, the command path compares CRC7 received in the response with the internally-generated CRC7. If the two do not match, the response CRC error is signaled to the BIU; that is, the response CRC error bit is set in the Raw Interrupt Status register.

Send Response to BIU

If the response_expected bit is set in the Command register, the received response is sent to the BIU. The Response0 register is updated for a short response, and the Response3, Response2, Response1, and Response0 registers are updated on a long response, after which the Command Done bit is set. If the response is for an auto_stop command sent by the CIU, the response is saved in the Response1 register, after which the Auto Command Done bit is set.

Additionally, the command path checks for the following:

- Transmission bit = 0
- Command index matches command index of the sent command

- End bit = 1 in received card response

The command index is not checked for a 136-bit response or if the check_response_crc bit is unset. For a 136-bit response and reserved CRC 48-bit responses, the command index is reserved—that is, 111111.

Driving P-bit on CMD Line

The command path drives a P-bit = 1 on the CMD line between two commands if a response is not expected. If a response is expected, the P-bit is driven after the response is received and before the start of the next command; this is done by asserting both ccmd_out and cc当地_出_en. If the command expects the Command Completion Signal, then the P-bit is driven only after receiving the Command Completion Signal. During initialization, the software should set the cc当地_od_pullup_en bit, which indicates an open-drain mode, during which the controller drives only a 0 or high-impedance (Z) on the command bus; a hard 1 is never driven in open-drain mode.

2. Data Path

The data path block pops the data FIFO and transmits data on cdata_out during a write data transfer, or it receives data on cdata_in and pushes it into the FIFO during a read data transfer. The data path loads new data parameters—that is, data expected, read/write data transfer, stream/block transfer, block size, byte count, card type, timeout registers—whenever a data transfer command is not in progress.

If the data_expected bit is set in the Command register, the new command is a data transfer command and the data path starts one of the following:

- Transmit data if the read/write bit = 1.
- Data receive if read/write bit = 0

Data Transmit

The data transmit state machine, illustrated in Fig.17-4, starts data transmission two clocks after a response for the data write command is received; this occurs even if the command path detects a response error or response CRC error. If a response is not received from the card because of a response timeout, data is not transmitted. Depending upon the value of the transfer_mode bit in the Command register, the data transmit state machine puts data on the card data bus in a stream or in block(s).

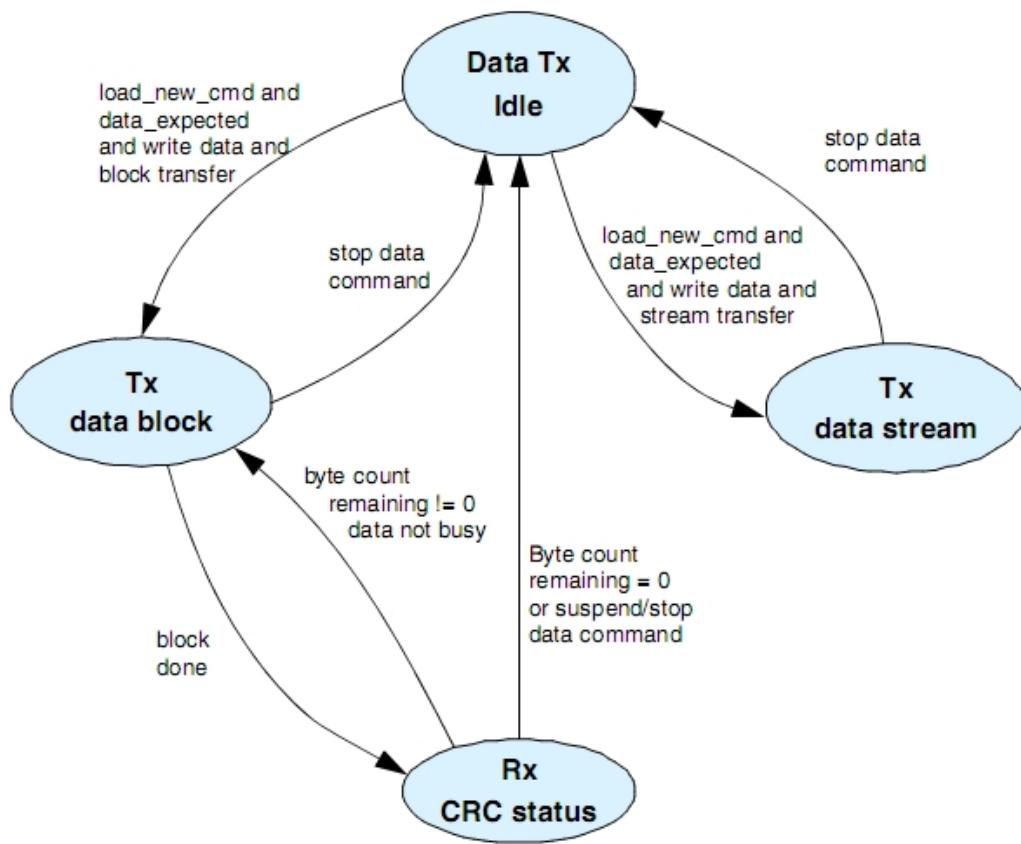


Fig. 17-4 SD/MMC Data Transmit State Machine

Stream Data Transmit

If the transfer_mode bit in the Command register is set to 1, it is a stream-write data transfer. The data path pops the FIFO from the BIU and transmits in a stream to the card data bus. If the FIFO becomes empty, the card clock is stopped and restarted once data is available in the FIFO.

If the byte_count register is programmed to 0, it is an open-ended stream-write data transfer. During this data transfer, the data path continuously transmits data in a stream until the host software issues a stop command. A stream data transfer is terminated when the end bit of the stop command and end bit of the data match over two clocks.

If the byte_count register is programmed with a non-zero value and the send_auto_stop bit is set in the Command register, the stop command is internally generated and loaded in the command path when the end bit of the stop command occurs after the last byte of the stream write transfer matches.

This data transfer can also terminate if the host issues a stop command before all the data bytes are transferred to the card bus.

Single Block Data

If the transfer_mode bit in the Command register is set to 0 and the byte_count register value is equal to the value of the block_size register, a single-block write-data transfer occurs. The data transmit state machine sends data in a single block, where the number of bytes equals the block size, including the internally-generated CRC16.

If the CTYPE register bit for the selected card – indicated by the card_num value in the Command register – is set for a 1-bit, 4-bit, or 8-bit data transfer, the data is transmitted on 1, 4, or 8 data lines, respectively, and CRC16 is separately generated and transmitted for 1, 4, or 8 data lines, respectively.

After a single data block is transmitted, the data transmit state machine receives the CRC status from the card and signals a data transfer to the BIU; this happens when the data-transfer-over bit is set in the RINTSTS register.

If a negative CRC status is received from the card, the data path signals a data CRC error to the BIU by setting the data CRC error bit in the RINTSTS register.

Additionally, if the start bit of the CRC status is not received by two clocks after the end of the data block, a CRC status start bit error is signaled to the BIU by setting the write-no-CRC bit in the RINTSTS register.

Multiple Block Data

A multiple-block write-data transfer occurs if the transfer_mode bit in the Command register is set to 0 and the value in the byte_count register is not equal to the value of the block_size register. The data transmit state machine sends data in blocks, where the number of bytes in a block equals the block size, including the internally-generated CRC16.

If the CTYPE register bit for the selected card – indicated by the card_num value in the Command register – is set to 1-bit, 4-bit, or 8-bit data transfer, the data is transmitted on 1, 4, or 8 data lines, respectively, and CRC16 is separately generated and transmitted on 1, 4, or 8 data lines, respectively.

After one data block is transmitted, the data transmit state machine receives the CRC status from the card. If the remaining byte_count becomes 0, the data path signals to the BIU that the data transfer is done; this happens when the data-transfer-over bit is set in the RINTSTS register.

If the remaining data bytes are greater than 0, the data path state machine starts to transmit another data block.

If a negative CRC status is received from the card, the data path signals a data CRC error to the BIU by setting the data CRC error bit in the RINTSTS register, and continues further data transmission until all the bytes are transmitted.

Additionally, if the CRC status start bit is not received by two clocks after the end of a data block, a CRC status start bit error is signaled to the BIU by setting the write-no-CRC bit in the RINTSTS register; further data transfer is terminated.

If the send_auto_stop bit is set in the Command register, the stop command is internally generated during the transfer of the last data block, where no extra bytes are transferred to the card. The end bit of the stop command may not exactly match the end bit of the CRC status in the last data block.

If the block size is less than 4, 16, or 32 for card data widths of 1 bit, 4 bits, or 8 bits, respectively, the data transmit state machine terminates the data transfer when all the data is transferred, at which time the internally generated stop command is loaded in the command path.

If the byte_count is 0 – the block size must be greater than 0 – it is an open-ended block transfer. The data transmit state machine for this type of data transfer continues the block-write data transfer until the host software issues a stop or abort command.

Data Receive

The data-receive state machine, illustrated in Fig.17-5, receives data two clock cycles after the end bit of a data read command, even if the command path detects a response error or response CRC error. If a response is not received from the card because a response timeout occurs, the BIU does not receive a signal that the data transfer is complete; this happens if the command sent by the SD/MMC Host Controller is an illegal operation for the card, which keeps the card from starting a read data transfer.

If data is not received before the data timeout, the data path signals a data

timeout to the BIU and an end to the data transfer done. Based on the value of the transfer_mode bit in the Command register, the data-receive state machine gets data from the card data bus in a stream or block(s).

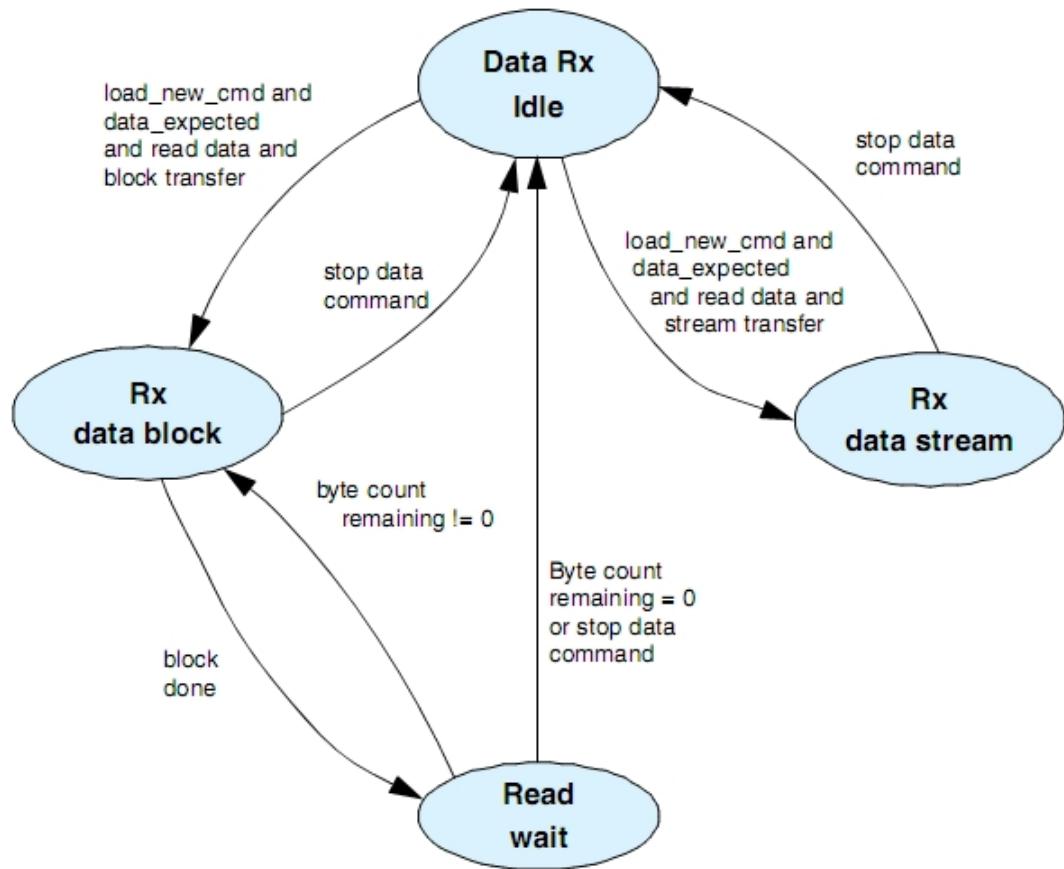


Fig. 17-5 SD/MMC Data Receive State Machine

Stream Data Read

A stream-read data transfer occurs if the transfer_mode bit in the Command register equals 1, at which time the data path receives data from the card and pushes it to the FIFO. If the FIFO becomes full, the card clock stops and restarts once the FIFO is no longer full.

An open-ended stream-read data transfer occurs if the byte_count register equals 0. During this type of data transfer, the data path continuously receives data in a stream until the host software issues a stop command. A stream data transfer terminates two clock cycles after the end bit of the stop command.

If the byte_count register contains a non-zero value and the send_auto_stop bit is set in the Command register, a stop command is internally generated and loaded into the command path, where the end bit of the stop command occurs after the last byte of the stream data transfer is received. This data transfer can terminate if the host issues a stop or abort command before all the data bytes are received from the card.

Single-Block Data Read

A single-block read-data transfer occurs if the transfer_mode bit in the Command register is set to 0 and the value of the byte_count register is equal to the value of the block_size register. When a start bit is received before the data times out, data bytes equal to the block size and CRC16 are received and checked with the internally-generated CRC16.

If the CTYPE register bit for the selected card – indicated by the card_num value in the Command register – is set to a 1-bit, 4-bit, or 8-bit data transfer, data is received from 1, 4, or 8 data lines, respectively, and CRC16 is separately generated and checked for 1, 4, or 8 data lines, respectively. If there is a CRC16 mismatch, the data path signals a data CRC error to the BIU. If the received end bit is not 1, the BIU receives an end-bit error.

Multiple-Block Data Read

If the transfer_mode bit in the Command register is set to 0 and the value of the byte_count register is not equal to the value of the block_size register, it is a multiple-block read-data transfer. The data-receive state machine receives data in blocks, where the number of bytes in a block is equal to the block size, including the internally-generated CRC16.

If the CTYPE register bit for the selected card – indicated by the card_num value in the Command register – is set to a 1-bit, 4-bit, or 8-bit data transfer, data is received from 1, 4, or 8 data lines, respectively, and CRC16 is separately generated and checked for 1, 4, or 8 data lines, respectively.

After a data block is received, if the remaining byte_count becomes 0, the data path signals a data transfer to the BIU.

If the remaining data bytes are greater than 0, the data path state machine causes another data block to be received. If CRC16 of a received data block does not match the internally-generated CRC16, a data CRC error to the BIU and data reception continue further data transmission until all bytes are transmitted.

Additionally, if the end of a received data block is not 1, data on the data path signals terminate the bit error to the CIU and the data-receive state machine terminates data reception, waits for data timeout, and signals to the BIU that the data transfer is complete.

If the send_auto_stop bit is set in the Command register, the stop command is internally generated when the last data block is transferred, where no extra bytes are transferred from the card; the end bit of the stop command may not exactly match the end bit of the last data block.

If the requested block size for data transfers to cards is less than 4, 16, or 32 bytes for 1-bit, 4-bit, or 8-bit data transfer modes, respectively, the data-transmit state machine terminates the data transfer when all data is transferred, at which point the internally-generated stop command is loaded in the command path. Data received from the card after that are then ignored by the data path.

If the byte_count is 0—the block size must be greater than 0—it is an open-ended block transfer. For this type of data transfer, the data-receive state machine continues the block-read data transfer until the host software issues a stop or abort command.

Auto-Stop

The SD/MMC Host Controller internally generates a stop command and is loaded in the command path when the send_auto_stop bit is set in the Command register. The auto-stop command helps to send an exact number of data bytes using a stream read or write for the MMC, and a multiple-block read or write for SD memory transfer for SD cards

The software should set the send_auto_stop bit according to details listed in Table 17-2.

Table 17- 2 Auto-Stop Generation

Card	Transfer type	Byte	send_auto_stop	Comments
------	---------------	------	----------------	----------

type		Count	bit set	
MMC	Stream read	0	No	Open-ended stradm
MMC	Stream read	>0	Yes	Auto-stop after all bytes transfer
MMC	Stream write	0	No	Open-ended stradm
MMC	Stream write	>0	Yes	Auto-stop after all bytes transfer
MMC	Single-block read	>0	No	Byte count =0 is illegal
MMC	Single-block write	>0	No	Byte count =0 is illegal
MMC	Multiple-block read	0	No	Open-ended multiple block
MMC	Multiple-block read	>0	Yes ^①	Pre-defined multiple block
MMC	Multiple-block write	0	No	Open-ended multiple block
MMC	Multiple-block write	>0	Yes ^①	Pre-defined multiple block
SDMEM	Single-block read	>0	No	Byte count =0 is illegal
SDMEM	Single-block write	>0	No	Byte count =0 illegal
SDMEM	Multiple-block read	0	No	Open-ended multiple block
SDMEM	Multiple-block read	>0	Yes	Auto-stop after all bytes transfer
SDMEM	Multiple-block write	0	No	Open-ended multiple block
SDMEM	Multiple-block write	>0	Yes	Auto-stop after all bytes transfer
SDIO	Single-block read	>0	No	Byte count =0 is illegal
SDIO	Single-block write	>0	No	Byte count =0 illegal
SDIO	Multiple-block read	0	No	Open-ended multiple block
SDIO	Multiple-block read	>0	No	Pre-defined multiple block
SDIO	Multiple-block write	0	No	Open-ended multiple block
SDIO	Multiple-block write	>0	No	Pre-defined multiple block

^①:The condition under which the transfer mode is set to block transfer and byte_count is equal to block size is treated as a single-block data transfer command for both MMC and SD cards. If byte_count = n*block_size (n = 2,3, ...), the condition is treated as a predefined multiple-block data transfer command. In the case of an MMC card, the host software can perform a predefined data transfer in two ways: 1) Issue the CMD23 command before issuing CMD18/CMD25 commands to the card – in this case, issue MD18/CMD25 commands without setting the send_auto_stop bit. 2) Issue CMD18/CMD25 commands without issuing CMD23 command to the card, with the send_auto_stop bit set. In this case, the multiple-block data transfer is terminated by an internally-generated auto-stop command after the programmed byte count.

The following list conditions for the auto-stop command.

- Stream read for MMC card with byte count greater than 0 – The SD/MMC Host Controller generates an internal stop command and loads it into the command path so that the end bit of the stop command is sent out when the last byte of data is read from the card and no extra data byte is received. If the byte count is less than 6 (48 bits), a few extra data bytes are received from the card before the end bit of the stop command is sent.
- Stream write for MMC card with byte count greater than 0 - The SD/MMC Host Controller generates an internal stop command and loads it into the command path so that the end bit of the stop command is sent when the last byte of data is transmitted on the card bus and no extra data byte is transmitted. If the byte count is less than 6 (48 bits), the data path transmits the data last in order to meet the above condition.
- Multiple-block read memory for SD card with byte count greater than 0 – If the block size is less than 4 (single-bit data bus), 16 (4-bit data bus), or 32

(8-bit data bus), the auto-stop command is loaded in the command path after all the bytes are read. Otherwise, the top command is loaded in the command path so that the end bit of the stop command is sent after the last data block is received.

- Multiple-block write memory for SD card with byte count greater than 0 – If the block size is less than 3 (single-bit data bus), 12 (4-bit data bus), or 24 (8-bit data bus), the auto-stop command is loaded in the command path after all data blocks are transmitted. Otherwise, the stop command is loaded in the command path so that the end bit of the stop command is sent after the end bit of the CRC status is received.
- Precaution for host software during auto-stop – Whenever an auto-stop command is issued, the host software should not issue a new command to the SD/MMC Host Controller until the auto-stop is sent by the SD/MMC Host Controller and the data transfer is complete. If the host issues a new command during a data transfer with the auto-stop in progress, an auto-stop command may be sent after the new command is sent and its response is received; this can delay sending the stop command, which transfers extra data bytes. For a stream write, extra data bytes are erroneous data that can corrupt the card data. If the host wants to terminate the data transfer before the data transfer is complete, it can issue a stop or abort command, in which case the SD/MMC Host Controller does not generate an auto-stop command.

3. Non-Data Transfer Commands that Use Data Path

Some non-data transfer commands (non-read/write commands) also use the data path. Table 17-3 lists the commands and register programming requirements for them.

Table 17-3 Non-data Transfer Commands and Requirements

	CMD27	CMD30	CMD42	AACMD 13	ACMD2 2	ACMD5 1
Command register programming						
Cmd_index	6'h1B	6'h1E	6'h2A	6'h0D	6'h16	6'h33
Response_expect	1	1	1	1	1	1
Response_length	0	0	0	0	0	0
Check_response_crc	1	1	1	1	1	1
Data_expected	1	1	1	1	1	1
Read/write	1	0	1	0	0	0
Transfer_mode	0	0	0	0	0	0
Send_auto_stop	0	0	0	0	0	0
Wait_prevdata_complete	0	0	0	0	0	0
Stop_abort_cmd	0	0	0	0	0	0
Command Argument register programming						
	Stuff bits	32-bit write protect data address	Stuff bits	Stuff bits	Stuff bits	Stuff bits

Block Size register programming						
	16	4	Num_byt es ^①	64	4	8
Byte Count register programming						
	16	4	Num_byt es ^①	64	4	8

^①: Num_bytes = No. of bytes specified as per the lock card data structure (Refer to the SD specification and the MMC specification)

4. SDIO Interrupt Control

Interrupts for SD cards are reported to the BIU by asserting an interrupt signal for two clock cycles. SDIO cards signal an interrupt by asserting cdata_in low during the interrupt period; an interrupt period for the selected card is determined by the interrupt control state machine. An interrupt period is always valid for non-active or non-selected cards, and 1-bit data mode for the selected card. An interrupt period for a wide-bus active or selected card is valid for the following conditions:

- Card is idle
- Non-data transfer command in progress
- Third clock after end bit of data block between two data blocks
- From two clocks after end bit of last data until end bit of next data transfer command

Bear in mind that, in the following situations, the SD/MMC Host Controller does not sample the SDIO interrupt of the selected card when the card data width is 4 bits. Since the SDIO interrupt is level-triggered, it is sampled in a further interrupt period and the host does not lose any SDIO interrupt from the card.

- A. Read/Write Resume – The CIU treats the resume command as a normal data transfer command. SDIO interrupts during the resume command are handled similarly to other data commands.

According to the SDIO specification, for the normal data command the interrupt period ends after the command end bit of the data command; for the resume command, it ends after the response end bit. In the case of the resume command, the SD/MMC Host Controller stops the interrupt sampling period after the resume command end bit, instead of stopping after the response end bit of the resume command.

- B. Suspend during read transfer – If the read data transfer is suspended by the host, the host sets the abort_read_data bit in the SD/MMC Host Controller to reset the data state machine. In the CIU, the SDIO interrupts are handled such that the interrupt sampling starts after the abort_read_data bit is set by the host. In this case the SD/MMC Host Controller does not sample SDIO interrupts between the period from response of the suspend command to setting the abort_read_data bit, and starts sampling after setting the abort_read_data bit.

5. Clock Control

The clock control block provides different clock frequencies required for SD_MMC cards. The cclk_in signal is the source clock ($cclk_{in} \geq$ card max operating frequency) for clock divider of the clock control block. This source clock (cclk_in) is used to generate different card clock frequencies

(sdmmc_clkout). The card clock can have different clock frequencies, since the SD card can be a low-speed SD card or a full-speed SD card. The SD/MMC Host Controller provides one clock signal (sdmmc_clkout).

The clock frequency of a card depends on the following clock control registers:

- Clock Divider register – Internal clock dividers are used to generate different clock frequencies required for card. The division factor for each clock divider can be programmed by writing to the Clock Divider register. The clock divider is an 8-bit value that provides a clock division factor from 1 to 510; a value of 0 represents a clock-divider bypass, a value of 1 represents a divide by 2, a value of 2 represents a divide by 4, and so on.
- Clock Control register – sdmmc_clkout can be enabled or disabled for each card under the following conditions:
 - ◆ clk_enable – sdmmc_clkout for a card is enabled if the clk_enable bit for a card in the Clock Control register is programmed (set to 1) or disabled (set to 0).
 - ◆ Low-power mode – Low-power mode of a card can be enabled by setting the low-power mode bit of the Clock Control register to 1. If low-power mode is enabled to save card power, the sdmmc_clkout is disabled when the card is idle for at least 8 card clock cycles. It is enabled when a new command is loaded and the command path goes to a non-idle state.

Additionally, sdmmc_clkout is disabled when an internal FIFO is full – card read (no more data can be received from card) – or when the FIFO is empty – card write (no data is available for transmission). This helps to avoid FIFO overrun and underrun conditions. It is used by the command and data path to qualify cclk_in for driving outputs and sampling inputs at the programmed clock frequency for the selected card, according to the Clock Divider and Clock Source register values.

Under the following conditions, the card clock is stopped or disabled, along with the active clk_en, for the selected card:

- Clock can be disabled by writing to Clock Enable register (clk_en bit = 1).
- If low-power mode is selected and card is idle, or not selected for 8 clocks.
- FIFO is full and data path cannot accept more data from the card and data transfer is incomplete –to avoid FIFO overrun.
- FIFO is empty and data path cannot transmit more data to the card and data transfer is incomplete – to avoid FIFO underrun.

6. Error Detection

- Response
 - ◆ Response timeout – Response expected with response start bit is not received within programmed number of clocks in timeout register.
 - ◆ Response CRC error – Response is expected and check response CRC requested; response CRC7 does not match with the internally-generated CRC7.
 - ◆ Response error – Response transmission bit is not 0, command index does not match with the command index of the send command, or response end bit is not 1.
- Data transmit
 - ◆ No CRC status – During a write data transfer, if the CRC status start bit is not received two clocks after the end bit of the data block is sent out, the data path does the following:
 - Signals no CRC status error to the BIU
 - Terminates further data transfer

- Signals data transfer done to the BIU
- ◆ Negative CRC – If the CRC status received after the write data block is negative (that is, not 010), a data CRC error is signaled to the BIU and further data transfer is continued.
- ◆ Data starvation due to empty FIFO – If the FIFO becomes empty during a write data transmission, or if the card clock is stopped and the FIFO remains empty for data timeout clocks, then a data-starvation error is signaled to the BIU and the data path continues to wait for data in the FIFO.
- Data receive
 - ◆ Data timeout – During a read-data transfer, if the data start bit is not received before the number of clocks that were programmed in the timeout register, the data path does the following:
 - Signals data-timeout error to the BIU
 - Terminates further data transfer
 - Signals data transfer done to BIU
 - ◆ Data start bit error – During a 4-bit or 8-bit read-data transfer, if the all-bit data line does not have a start bit, the data path signals a data start bit error to the BIU and waits for a data timeout, after which it signals that the data transfer is done.
 - ◆ Data CRC error – During a read-data-block transfer, if the CRC16 received does not match with the internally generated CRC16, the data path signals a data CRC error to the BIU and continues further data transfer.
 - ◆ Data end-bit error – During a read-data transfer, if the end bit of the received data is not 1, the data path signals an end-bit error to the BIU, terminates further data transfer, and signals to the BIU that the data transfer is done.
 - ◆ Data starvation due to FIFO full – During a read data transmission and when the FIFO becomes full, the card clock is stopped. If the FIFO remains full for data timeout clocks, a data starvation error is signaled to the BIU (Data Starvation by Host Timeout bit is set in RINTSTS Register) and the data path continues to wait for the FIFO to start to empty.

17.4 Register description

17.4.1 Register Summary

Name	Offset	Size	Reset Value	Description
SDMMC_CTRL	0x0000	W	0x00000000	Control register
SDMMC_PWREN	0x0004	W	0x00000000	Power-enable register
SDMMC_CLKDIV	0x0008	W	0x00000000	Clock-divider register
SDMMC_CLKENA	0x0010	W	0x00000000	Clock-enable register
SDMMC_TMOUT	0x0014	W	0xfffffff40	Time-out register
SDMMC_CTYPE	0x0018	W	0x00000000	Card-type register
SDMMC_BLKSIZ	0x001c	W	0x00000200	Block-size register
SDMMC_BYTCNT	0x0020	W	0x00000200	Byte-count register
SDMMC_INTMASK	0x0024	W	0x00000000	Interrupt-mask register
SDMMC_CMDARG	0x0028	W	0x00000000	Command-argument register

Name	Offset	Size	Reset Value	Description
SDMMC_CMD	0x002c	W	0x00000000	Command register
SDMMC_RESP0	0x0030	W	0x00000000	Response-0 register
SDMMC_RESP1	0x0034	W	0x00000000	Response-1 register
SDMMC_RESP2	0x0038	W	0x00000000	Response-2 register
SDMMC_RESP3	0x003c	W	0x00000000	Response-3 register
SDMMC_MINTSTS	0x0040	W	0x00000000	Masked interrupt-status register
SDMMC_RINTSTS	0x0044	W	0x00000000	Raw interrupt-status register
SDMMC_STATUS	0x0048	W	0x00000406	Status register
SDMMC_FIFOTH	0x004c	W	0x00000000	FIFO threshold register
SDMMC_CDETECT	0x0050	W	0x00000000	Card-detect register
SDMMC_WRTPRT	0x0054	W	0x00000000	Write-protect register
SDMMC_TCBCNT	0x005c	W	0x00000000	Transferred CIU card byte count
SDMMC_TBBCNT	0x0060	W	0x00000000	Transferred host/DMA to/from BIU-FIFO byte count
SDMMC_DEBNCE	0x0064	W	0x0fffffff	Card detect debounce register
SDMMC_USRID	0x0068	W	0x00000000	User ID register
SDMMC_VERID	0x006c	W	0x5342240a	Version ID register
SDMMC_UHS_REG	0x0074	W	0x00000000	UHS-1 register
SDMMC_RST_n	0x0078	W	0x00000001	Hardware reset register
SDMMC_CARDTHRCTL	0x0100	W	0x00000000	Card Read Threshold Enable
SDMMC_BACK_END_POWER	0x0104	W	0x00000000	Back-end Power
SDMMC_FIFO_BASE	0x0200	W	0x00000000	

Notes: **S**-Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

17.4.2 Detail Register Description

SDMMC_CTRL

Address: Operational Base + offset (0x0000)
Control register

Bit	Attr	Reset Value	Description
31:9	RO	0x0	reserved

Bit	Attr	Reset Value	Description
8	RW	0x0	<p>abort_read_data 0 –No change 1 –After suspend command is issued during read-transfer, software polls card to find when suspend happened. Once suspend occurs, software sets bit to reset data state-machine, which is waiting for next block of data. Bit automatically clears once data state machine resets to idle. Used in SDIO card suspend sequence.</p>
7	RW	0x0	<p>send_irq_response 0 –No change 1 –Send auto IRQ response Bit automatically clears once response is sent. To wait for MMC card interrupts, host issues CMD40, and SDMMC Controller waits for interrupt response from MMC card(s). In meantime, if host wants SDMMC Controller to exit waiting for interrupt state, it can set this bit, at which time SDMMC Controller command state-machine sends CMD40 response on bus and returns to idle state.</p>
6	RW	0x0	<p>read_wait 0 –Clear read wait 1 –Assert read wait For sending read-wait to SDIO cards</p>
5	RW	0x0	<p>dma_enable 0 –Disable DMA transfer mode 1 –Enable DMA transfer mode Even when DMA mode is enabled, host can still push/pop data into or from FIFO; this should not happen during the normal operation. If there is simultaneous FIFO access from host/DMA, the data coherency is lost. Also, there is no arbitration inside SDMMC Controller to prioritize simultaneous host/DMA access.</p>
4	RW	0x0	<p>int_enable Global interrupt enable/disable bit: 0 –Disable interrupts 1 –Enable interrupts The int port is 1 only when this bit is 1 and one or more unmasked interrupts are set.</p>
3	RO	0x0	reserved

Bit	Attr	Reset Value	Description
2	W1C	0x0	<p>dma_reset 0 –No change 1 –Reset internal DMA interface control logic To reset DMA interface, firmware should set bit to 1. This bit is auto-cleared after two AHB clocks.</p>
1	W1C	0x0	<p>fifo_reset 0 –No change 1 –Reset to data FIFO To reset FIFO pointers To reset FIFO, firmware should set bit to 1. This bit is auto-cleared after completion of reset operation</p>
0	W1C	0x0	<p>controller_reset 0 –No change 1 –Reset SDMMC controller To reset controller, firmware should set bit to 1. This bit is auto-cleared after two AHB and two cclk_in clock cycles. This resets: <ul style="list-style-type: none"> * BIU/CIU interface * CIU and state machines * abort_read_data, send_irq_response, and read_wait bits of Control register * start_cmd bit of Command register Does not affect any registers or DMA interface, or FIFO or host interrupts </p>

SDMMC_PWREN

Address: Operational Base + offset (0x0004)

Power-enable register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	<p>power_enable Power on/off switch for the card. Once power is turned on, firmware should wait for regulator/switch ramp-up time before trying to initialize card. 0 –power off 1 –power on Bit values output to card_power_en port.</p>

SDMMC_CLKDIV

Address: Operational Base + offset (0x0008)

Clock-divider register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x00	clk_divider0 Clock divider-0 value. Clock division is 2^n . For example, value of 0 means divide by $2^0 = 1$ (no division, bypass), value of 1 means divide by $2^1 = 2$, value of "ff" on.In MMC-Ver3.3-only mode, bits not implemented because only one clock divider is supported.

SDMMC_CLKENA

Address: Operational Base + offset (0x0010)
Clock-enable register

Bit	Attr	Reset Value	Description
31:17	RO	0x0	reserved
16	RW	0x0	cclk_low_power Low-power control for SD card clock and MMC card clock supported. 0 – Non-low-power mode 1 – Low-power mode; stop clock when card in IDLE (should be normally set to only MMC and SD memory cards; for SDIO cards, if interrupts must be detected, clock should not be stopped).
15:1	RO	0x0	reserved
0	RW	0x0	cclk_enable Clock-enable control for SD card clock and MMC card clock supported. 0 – Clock disabled 1 – Clock enabled

SDMMC_TMOUT

Address: Operational Base + offset (0x0014)
Time-out register

Bit	Attr	Reset Value	Description
31:8	RW	0xffffffff	data_timeout Value for card Data Read Timeout; same value also used for Data Starvation by Host timeout. Value is in number of card output clocks – cclk_out of selected card.
7:0	RW	0x40	response_timeout Response timeout value. Value is in number of card output clocks – cclk_out.

SDMMC_CTYPE

Address: Operational Base + offset (0x0018)

Card-type register

Bit	Attr	Reset Value	Description
31:17	RO	0x0	reserved
16	RW	0x0	card_width_8 Indicates if card is 8-bit: 0 –Non 8-bit mode 1 –8-bit mode
15:1	RO	0x0	reserved
0	RW	0x0	card_width Indicates if card is 1-bit or 4-bit: 0 –1-bit mode 1 –4-bit mode

SDMMC_BLKSIZ

Address: Operational Base + offset (0x001c)

Block-size register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0200	block_size Block size

SDMMC_BYTCNT

Address: Operational Base + offset (0x0020)

Byte-count register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000200	byte_count Number of bytes to be transferred; should be integer multiple of Block Size for block transfers. For undefined number of byte transfers, byte count should be set to 0. When byte count is set to 0, it is responsibility of host to explicitly send stop/abort command to terminate data transfer.

SDMMC_INTMASK

Address: Operational Base + offset (0x0024)

Interrupt-mask register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved

Bit	Attr	Reset Value	Description
24	RW	0x0	sdio_int_mask Mask SDIO interrupts When masked, SDIO interrupt detection for that card is disabled. A 0 masks an interrupt, and 1 enables an interrupt.
23:17	RO	0x0	reserved
16	RW	0x0	new_int_mask New Interrupt Mask 1: data no busy interrupt masked
15:0	RW	0x0000	int_mask Bits used to mask unwanted interrupts. Value of 0 masks interrupt; value of 1 enables interrupt. bit 15 –End-bit error (read)/Write no CRC (EBE) bit 14 –Auto command done (ACD) bit 13 –Start-bit error (SBE) bit 12 –Hardware locked write error (HLE) bit 11 –FIFO underrun/overrun error (FRUN) bit 10 –Data starvation-by-host timeout (HTO) /Volt_switch_int bit 9 –Data read timeout (DRTO) bit 8 –Response timeout (RTO) bit 7 –Data CRC error (DCRC) bit 6 –Response CRC error (RCRC) bit 5 –Receive FIFO data request (RXDR) bit 4 –Transmit FIFO data request (TXDR) bit 3 –Data transfer over (DTO) bit 2 –Command done (CD) bit 1 –Response error (RE) bit 0 –Card detect (CD)

SDMMC_CMDARG

Address: Operational Base + offset (0x0028)

Command-argument register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	cmd_arg Value indicates command argument to be passed to card.

SDMMC_CMD

Address: Operational Base + offset (0x002c)

Command register

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>start_cmd Start command. Once command is taken by CIU, bit is cleared.</p> <p>When bit is set, host should not attempt to write to any command registers. If write is attempted, hardware lock error is set in raw interrupt register.</p> <p>Once command is sent and response is received from SD_MMC cards, Command Done bit is set in raw interrupt register.</p>
30	RO	0x0	reserved
29	RW	0x0	<p>use_hold_reg Use Hold Register</p> <p>0 - CMD and DATA sent to card bypassing HOLD Register</p> <p>1 - CMD and DATA sent to card through the HOLD Register</p> <p>Note:</p> <ul style="list-style-type: none"> a. Set to 1'b1 for SDR12 and SDR25 (with non-zero phase-shifted cclk_in_drv); zero phase shift is not allowed in these modes. b. Set to 1'b0 for SDR50, and DDR50 (with zero phase-shifted cclk_in_drv) c. Set to 1'b1 for SDR50, and DDR50 (with non-zero phase-shifted cclk_in_drv)
28	RW	0x0	<p>volt_switch Voltage switch bit</p> <p>0 - No voltage switching</p> <p>1 - Voltage switching enabled; must be set for CMD11 only</p>
27	RW	0x0	<p>boot_mode Boot Mode</p> <p>0 - Mandatory Boot operation</p> <p>1 - Alternate Boot operation</p>
26	RW	0x0	<p>disable_boot Disable Boot. When software sets this bit along with start_cmd, CIU terminates the boot operation. Do NOT set disable_boot and enable_boot together.</p>

Bit	Attr	Reset Value	Description
25	RW	0x0	expect_boot_ack Expect Boot Acknowledge. When Software sets this bit along with enable_boot, CIU expects a boot acknowledge start pattern of 0-1-0 from the selected card.
24	RW	0x0	enable_boot Enable Boot—this bit should be set only for mandatory boot mode. When Software sets this bit along with start_cmd, CIU starts the boot sequence for the corresponding card by asserting the CMD line low. Do NOT set disable_boot and enable_boot together.
23:22	RO	0x0	reserved
21	RW	0x0	update_clock_registers_only 0 –Normal command sequence 1 –Do not send commands, just update clock register value into card clock domain. Following register values transferred into card clock domain: CLKDIV, CLRSRC, CLKENA. Changes card clocks (change frequency, truncate off or on, and set low-frequency mode); provided in order to change clock frequency or stop clock without having to send command to cards. During normal command sequence, when update_clock_registers_only = 0, following control registers are transferred from BIU to CIU: CMD, CMDARG, TMOUT, CTYPE, BLKSIZ, BYTCNT. CIU uses new register values for new command sequence to card. When bit is set, there are no Command Done interrupts because no command is sent to SD_MMC cards.
20:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15	RW	0x0	<p>send_initialization</p> <p>0 –Do not send initialization sequence (80 clocks of 1) before sending this command 1 –Send initialization sequence before sending this command</p> <p>After power on, 80 clocks must be sent to card for initialization before sending any commands to card. Bit should be set while sending first command to card so that controller will initialize clocks before sending command to card. This bit should not be set for either of the boot modes (alternate or mandatory).</p>
14	RW	0x0	<p>stop_abort_cmd</p> <p>0 –Neither stop nor abort command to stop current data transfer in progress. If abort is sent to function-number currently selected or not in data-transfer mode, then bit should be set to 0.</p> <p>1 –Stop or abort command intended to stop current data transfer in progress.</p> <p>When open-ended or predefined data transfer is in progress, and host issues stop or abort command to stop data transfer, bit should be set so that command/data state-machines of CIU can return correctly to idle state. This is also applicable for Boot mode transfers. To Abort boot mode, this bit should be set along with CMD[26] = disable_boot.</p>
13	RW	0x0	<p>wait_prvdata_complete</p> <p>0 –Send command at once, even if previous data transfer has not completed 1 –Wait for previous data transfer completion before sending command</p> <p>The wait_prvdata_complete = 0 option typically used to query status of card during data transfer or to stop current data transfer; card_number should be same as in previous command.</p>

Bit	Attr	Reset Value	Description
12	RW	0x0	<p>send_auto_stop 0 – No stop command sent at end of data transfer 1 – Send stop command at end of data transfer When set, SDMMC Controller sends stop command to SD_MMC cards at end of data transfer.</p> <ul style="list-style-type: none"> * when send_auto_stop bit should be set, since some data transfers do not need explicit stop commands * open-ended transfers that software should explicitly send to stop command <p>Additionally, when “resume” is sent to resume –suspended memory access of SD-Combo card –bit should be set correctly if suspended data transfer needs send_auto_stop.</p> <p>Don't care if no data expected from card.</p>
11	RW	0x0	<p>transfer_mode 0 – Block data transfer command 1 – Stream data transfer command</p> <p>Don't care if no data expected.</p>
10	RW	0x0	<p>wr 0 – Read from card 1 – Write to card</p> <p>Don't care if no data expected from card.</p>
9	RW	0x0	<p>data_expected 0 – No data transfer expected (read/write) 1 – Data transfer expected (read/write)</p>
8	RW	0x0	<p>check_response_crc 0 – Do not check response CRC 1 – Check response CRC</p> <p>Some of command responses do not return valid CRC bits. Software should disable CRC checks for those commands in order to disable CRC checking by controller</p>
7	RW	0x0	<p>response_length 0 – Short response expected from card 1 – Long response expected from card</p>
6	RW	0x0	<p>response_expect 0 – No response expected from card 1 – Response expected from card</p>

Bit	Attr	Reset Value	Description
5:0	RW	0x00	cmd_index Command index

SDMMC_RESP0

Address: Operational Base + offset (0x0030)

Response-0 register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	response0 Bit[31:0] of response

SDMMC_RESP1

Address: Operational Base + offset (0x0034)

Response-1 register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	response Register represents bit[63:32] of long response. When CIU sends auto-stop command, then response is saved in register. Response for previous command sent by host is still preserved in Response 0 register. Additional auto-stop issued only for data transfer commands, and response type is always "short" for them.

SDMMC_RESP2

Address: Operational Base + offset (0x0038)

Response-2 register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	response2 Bit[95:64] of long response

SDMMC_RESP3

Address: Operational Base + offset (0x003c)

Response-3 register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	response3 Bit[127:96] of long response

SDMMC_MINTSTS

Address: Operational Base + offset (0x0040)

Masked interrupt-status register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved

Bit	Attr	Reset Value	Description
24	RO	0x0	<p>sdio_interrupt Interrupt from SDIO card; SDIO interrupt for card enabled only if corresponding sdio_int_mask bit is set in Interrupt mask register (mask bit 1 enables interrupt; 0 masks interrupt).</p> <p>0 –No SDIO interrupt from card 1 –SDIO interrupt from card</p>
23:17	RO	0x0	reserved
16	RW	0x0	<p>new_int_status New Interrupt Status 0: data_no busy int</p>
15:0	RO	0x0000	<p>int_status Interrupt enabled only if corresponding bit in interrupt mask register is set.</p> <p>bit 15 –End-bit error (read)/write no CRC (EBC) bit 14 –Auto command done (ACD) bit 13 –Start-bit error (SBE) bit 12 –Hardware locked write error (HLE) bit 11 –FIFO underrun/overrun error (FRUN) bit 10 –Data starvation by host timeout (HTO)/Volt_switch_int bit 9 –Data read timeout (DRTO) bit 8 –Response timeout (RTO) bit 7 –Data CRC error (DCRC) bit 6 –Response CRC error (RCRC) bit 5 –Receive FIFO data request (RXDR) bit 4 –Transmit FIFO data request (TXDR) bit 3 –Data transfer over (DTO) bit 2 –Command done (CD) bit 1 –Response error (RE) bit 0 –Card detect (CD)</p>

SDMMC_RINTSTS

Address: Operational Base + offset (0x0044)

Raw interrupt-status register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved

Bit	Attr	Reset Value	Description
24	RO	0x0	<p>sdio_interrupt Interrupt from SDIO card; Writes to these bits clear them. Value of 1 clears bit and 0 leaves bit intact.</p> <p>0 –No SDIO interrupt from card 1 –SDIO interrupt from card</p>
23:17	RO	0x0	reserved
16	RW	0x0	<p>new_int_status New Interrupt Status 0: data no busy int</p>
15:0	RO	0x0000	<p>int_status Writes to bits clear status bit. Value of 1 clears status bit, and value of 0 leaves bit intact. Bits are logged regardless of interrupt mask status.</p> <p>bit 15 –End-bit error (read)/write no CRC (EBE) bit 14 –Auto command done (ACD) bit 13 –Start-bit error (SBE) bit 12 –Hardware locked write error (HLE) bit 11 –FIFO underrun/overrun error (FRUN) bit 10 –Data starvation-by-host timeout (HTO) /Volt_switch_int bit 9 –Data read timeout (DRTO)/Boot Data Start (BDS) bit 8 –Response timeout (RTO)/Boot Ack Received (BAR) bit 7 –Data CRC error (DCRC) bit 6 –Response CRC error (RCRC) bit 5 –Receive FIFO data request (RXDR) bit 4 –Transmit FIFO data request (TXDR) bit 3 –Data transfer over (DTO) bit 2 –Command done (CD) bit 1 –Response error (RE) bit 0 –Card detect (CD)</p>

SDMMC_STATUS

Address: Operational Base + offset (0x0048)

Status register

Bit	Attr	Reset Value	Description
31	RO	0x0	<p>dma_req DMA request signal state</p>

Bit	Attr	Reset Value	Description
30	RO	0x0	dma_ack DMA acknowledge signal state
29:17	RO	0x0000	fifo_count FIFO count –Number of filled locations in FIFO
16:11	RO	0x00	response_index Index of previous response, including any auto-stop sent by core
10	RO	0x1	data_state_mc_busy Data transmit or receive state-machine is busy
9	RO	0x0	data_busy Inverted version of raw selected card_data[0] 0 –card data not busy 1 –card data busy default value is 1 or 0 depending on cdata_in
8	RO	0x0	data_3_status Raw selected card_data[3]; checks whether card is present 0 –card not present 1 –card present default value is 1 or 0 depending on cdata_in

Bit	Attr	Reset Value	Description
7:4	RO	0x0	<p>command_fsm_states Command FSM states:</p> <ul style="list-style-type: none"> 0 –Idle 1 –Send init sequence 2 –Tx cmd start bit 3 –Tx cmd tx bit 4 –Tx cmd index + arg 5 –Tx cmd crc7 6 –Tx cmd end bit 7 –Rx resp start bit 8 –Rx resp IRQ response 9 –Rx resp tx bit 10 –Rx resp cmd idx 11 –Rx resp data 12 –Rx resp crc7 13 –Rx resp end bit 14 –Cmd path wait NCC 15 –Wait; CMD-to-response turnaround <p>NOTE: The command FSM state is represented using 19 bits.</p> <p>The STATUS Register(7:4) has 4 bits to represent the command FSM states. Using these 4 bits, only 16 states can be represented. Thus three states cannot be represented in the STATUS(7:4) register. The three states that are not represented in the STATUS Register(7:4) are:</p> <ul style="list-style-type: none"> * Bit 16 –Wait for CCS * Bit 17 –Send CCSD * Bit 18 –Boot Mode <p>Due to this, while command FSM is in “Wait for CCS state” or “Send CCSD” or “Boot Mode”, the Status register indicates status as 0 for the bit field 7:4.</p>
3	RO	0x0	fifo_full FIFO is full status
2	RO	0x1	fifo_empty FIFO is empty status
1	RO	0x1	fifo_tx_watermark FIFO reached Transmit watermark level; not qualified with data transfer

Bit	Attr	Reset Value	Description
0	RO	0x0	fifo_rx_watermark FIFO reached Receive watermark level; not qualified with data transfer

SDMMC_FIFOTH

Address: Operational Base + offset (0x004c)

FIFO threshold register

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved

Bit	Attr	Reset Value	Description
30:28	RW	0x0	<p>DMA_Mutiple_Transaction_Size Burst size of multiple transaction; should be programmed same as DMA controller multiple-transaction-size SRC/DEST_MSIZE.</p> <p>000 - 1 transfers 001 - 4 010 - 8 011 - 16 100 - 32 101 - 64 110 - 128 111 - 256</p> <p>The units for transfers is the H_DATA_WIDTH parameter. A single transfer would be signalled based on this value.</p> <p>Value should be sub-multiple of (RX_WMark + 1)* (F_DATA_WIDTH/H_DATA_WIDTH) and (FIFO_DEPTH - TX_WMark)* (F_DATA_WIDTH/H_DATA_WIDTH)</p> <p>For example, if FIFO_DEPTH = 16, $FDATA_WIDTH == H_DATA_WIDTH$</p> <p>Allowed combinations for MSize and TX_WMark are:</p> <ul style="list-style-type: none"> MSize = 1, TX_WMARK = 1-15 MSize = 4, TX_WMark = 8 MSize = 4, TX_WMark = 4 MSize = 4, TX_WMark = 12 MSize = 8, TX_WMark = 8 MSize = 8, TX_WMark = 4 <p>Allowed combinations for MSize and RX_WMark are:</p> <ul style="list-style-type: none"> MSize = 1, RX_WMARK = 0-14 MSize = 4, RX_WMark = 3 MSize = 4, RX_WMark = 7 MSize = 4, RX_WMark = 11 MSize = 8, RX_WMark = 7 <p>Recommended:</p> <p style="text-align: right;">MSize = 8, TX_WMark = 8, RX_WMark = 7</p>

Bit	Attr	Reset Value	Description
27:16	RW	0x000	<p>RX_WMark FIFO threshold watermark level when receiving data to card. When FIFO data count reaches greater than this number, DMA/FIFO request is raised. During end of packet, request is generated regardless of threshold programming in order to complete any remaining data.</p> <p>In non-DMA mode, when receiver FIFO threshold (RXDR) interrupt is enabled, then interrupt is generated instead of DMA request. During end of packet, interrupt is not generated if threshold programming is larger than any remaining data. It is responsibility of host to read remaining bytes on seeing Data Transfer Done interrupt.</p> <p>In DMA mode, at end of packet, even if remaining bytes are less than threshold, DMA request does single transfers to flush out any remaining bytes before Data Transfer Done interrupt is set.</p> <p>12 bits – 1 bit less than FIFO-count of status register, which is 13 bits.</p> <p>Limitation: RX_WMark <= FIFO_DEPTH-2 Recommended: (FIFO_DEPTH/2) - 1; (means greater than (FIFO_DEPTH/2) - 1) NOTE: In DMA mode during CCS time-out, the DMA does not generate the request at the end of packet, even if remaining bytes are less than threshold. In this case, there will be some data left in the FIFO. It is the responsibility of the application to reset the FIFO after the CCS timeout.</p>
15:12	RO	0x0	reserved

Bit	Attr	Reset Value	Description
11:0	RW	0x000	<p>TX_WMark FIFO threshold watermark level when transmitting data to card. When FIFO data count is less than or equal to this number, DMA/FIFO request is raised. If Interrupt is enabled, then interrupt occurs. During end of packet, request or interrupt is generated, regardless of threshold programming.</p> <p>In non-DMA mode, when transmit FIFO threshold (TXDR) interrupt is enabled, then interrupt is generated instead of DMA request. During end of packet, on last interrupt, host is responsible for filling FIFO with only required remaining bytes (not before FIFO is full or after CIU completes data transfers, because FIFO may not be empty).</p> <p>In DMA mode, at end of packet, if last transfer is less than burst size, DMA controller does single cycles until required bytes are transferred. 12 bits – 1 bit less than FIFO-count of status register, which is 13 bits. Limitation: TX_WMark \geq 1; Recommended: FIFO_DEPTH/2; (means less than or equal to FIFO_DEPTH/2)</p>

SDMMC_CDETECT

Address: Operational Base + offset (0x0050)

Card-detect register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RO	0x0	card_detect_n Value on card_detect_n input ports; read-only bits. 0 represents presence of card.

SDMMC_WRTPRT

Address: Operational Base + offset (0x0054)

Write-protect register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	write_protect Value on card_write_prt input port. 1 represents write protection.

SDMMC_TCBCNT

Address: Operational Base + offset (0x005c)

Transferred CIU card byte count

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	<p>trans_card_byte_count Number of bytes transferred by CIU unit to card.</p> <p>In 32-bit or 64-bit AMBA data-bus-width modes, register should be accessed in full to avoid read-coherency problems. In 16-bit AMBA data-bus-width mode, internal 16-bit coherency register is implemented. User should first read lower 16 bits and then higher 16 bits. When reading lower 16 bits, higher 16 bits of counter are stored in temporary register. When higher 16 bits are read, data from temporary register is supplied.</p> <p>Both TCBCNT and TBBCNT share same coherency register.</p> <p>When AREA_OPTIMIZED parameter is 1, register should be read only after data transfer completes; during data transfer, register returns 0.</p>

SDMMC_TBBCNT

Address: Operational Base + offset (0x0060)

Transferred host/DMA to/from BIU-FIFO byte count

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	<p>trans_fifo_byte_count Number of bytes transferred between Host/DMA memory and BIU FIFO.</p> <p>In 32-bit or 64-bit AMBA data-bus-width modes, register should be accessed in full to avoid read-coherency problems. In 16-bit AMBA data-bus-width mode, internal 16-bit coherency register is implemented. User should first read lower 16 bits and then higher 16 bits. When reading lower 16 bits, higher 16 bits of counter are stored in temporary register. When higher 16 bits are read, data from temporary register is supplied.</p> <p>Both TCBCNT and TBBCNT share same coherency register.</p>

SDMMC_DEBNCE

Address: Operational Base + offset (0x0064)

Card detect debounce register

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23:0	RW	0xffffffff	debounce_count Number of host clocks (clk) used by debounce filter logic; typical debounce time is 5-25 ms.

SDMMC_USRID

Address: Operational Base + offset (0x0068)

User ID register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	USRID User identification register; value set by user. Default reset value can be picked by user while configuring core before synthesis. Can also be used as scratch pad register by user. the default value is determined by Configuration Value.

SDMMC_VERID

Address: Operational Base + offset (0x006c)

Version ID register

Bit	Attr	Reset Value	Description
31:0	RO	0x5342240a	VERID Version identification register; register value is hard-wired. Can be read by firmware to support different versions of core.

SDMMC_UHS_REG

Address: Operational Base + offset (0x0074)

UHS-1 register

Bit	Attr	Reset Value	Description
31:17	RO	0x0	reserved
16	RW	0x0	DDR_REG DDR mode. Determines the voltage fed to the buffers by an external voltage regulator. 0 –Non-DDR mode 1 –DDR mode UHS_REG [16] should be set for card

Bit	Attr	Reset Value	Description
15:1	RO	0x0	reserved
0	RW	0x0	<p>VOLT_REG High Voltage mode. Determines the voltage fed to the buffers by an external voltage regulator.</p> <p>0 –Buffers supplied with 3.3V Vdd 1 –Buffers supplied with 1.8V Vdd</p> <p>These bits function as the output of the host controller and are fed to an external voltage regulator. The voltage regulator must switch the voltage of the buffers of a particular card to either 3.3V or 1.8V, depending on the value programmed in the register.</p> <p>VOLT_REG[0] should be set to 1'b1 for card in order to make it operate for 1.8V.</p>

SDMMC_RST_n

Address: Operational Base + offset (0x0078)

Hardware reset register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x1	<p>CARD_RESET Hardware reset.</p> <p>1 –Active mode 0 –Reset</p> <p>These bits cause the cards to enter pre-idle state, which requires them to be re-initialized.</p> <p>CARD_RESET[0] should be set to 1'b1 to reset card</p>

SDMMC_CARDTHRCTL

Address: Operational Base + offset (0x0100)

Card Read Threshold Enable

Bit	Attr	Reset Value	Description
31:28	RO	0x0	reserved
27:16	RW	0x000	<p>CardRdThreshold Card Read Threshold size</p>
15:1	RO	0x0	reserved

Bit	Attr	Reset Value	Description
0	RW	0x0	CardRdThrEn Card Read Threshold Enable 1'b0 - Card Read Threshold disabled 1'b1 - Card Read Threshold enabled. Host Controller initiates Read Transfer only if CardRdThreshold amount of space is available in receive FIFO.

SDMMC_BACK_END_POWER

Address: Operational Base + offset (0x0104)

Back-end Power

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	Back_End_Power Back end power 1'b0 -Off; Reset 1'b1 -Back-end Power supplied to card application

SDMMC_FIFO_BASE

Address: Operational Base + offset (0x0200)

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	fifo_base_addr fifo base addr

17.5 Timing Diagram

17.6 Interface description

17.6.1 Card-Detect and Write-Protect Mechanism

Figure 17-6 illustrates how the SD/MMC Host Controller card detection and write-protect signals are connected. Most of the SD_MMC sockets have card-detect pins. When no card is present, card_detect_n is 1 due to the pull-up. When the SD_MMC card is inserted, the card-detect pin is shorted to ground, which makes card_detect_n go to 0. Similarly in SD cards, when the write-protect switch is toward the left, it shorts the write_protect port to ground.

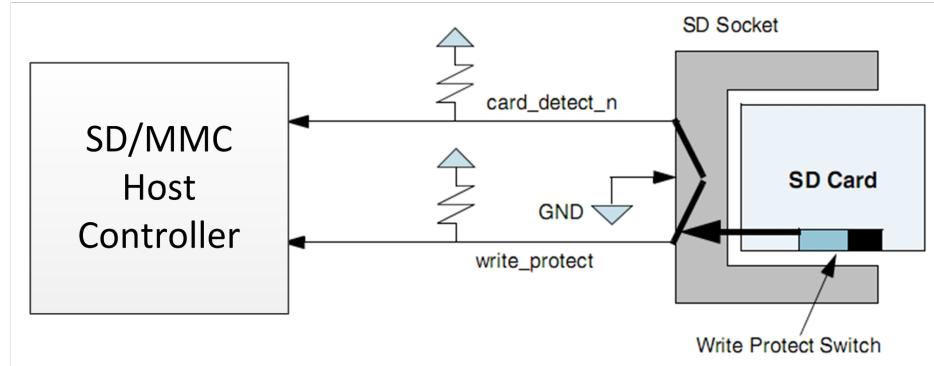


Fig. 17-6 Card-Detect and Write-Protect

17.6.2 SD/MMC Controller Termination Requirement

Fig.17-7 illustrates the SD/MMC Host Controller termination requirements, which is required to pull up ccmd and cdata lines on the SD_MMC bus. The recommended specification for pull-up on the ccmd line (Rcmd) is 4.7K - 100K for MMC, and 10K - 100K for an SD. The recommended pull-up on the cdata line (Rdat) is 50K - 100K.

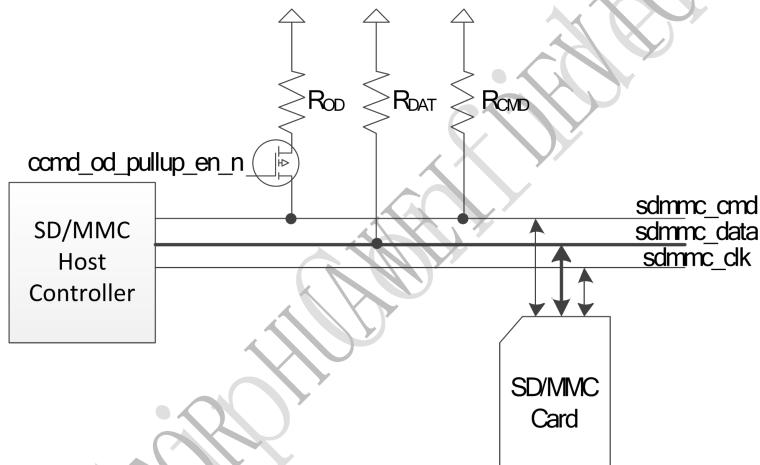


Fig. 17-7 SD/MMC Termination

Rcmd and Rod Calculation

The SD and MMC card enumeration happens at a very low frequency – 100-400KHz. Since the MMC bus is a shared bus between multiple cards, during enumeration open-drive mode is used to avoid bus conflict. Cards that drive 0 win over cards that drive “z.” The pull-up in the command line pulls the bus to 1 when all cards drive “z.” MMC interrupt mode also uses the pull-up. During normal data transfer, the host chooses only one card and the card driver switches to push-pull mode.

For example, if enumeration is done at 400KHz and the total bus capacitance is 200 pf, the pull-up needed during enumeration is:

$$2.2 \text{ RC} = \text{rise-time} = 1/400\text{KHz}$$

$$\begin{aligned} R &= 1/(2.2 * C * 100\text{KHz}) \\ &= 1/(2.2 * 200 * 10^{**-12} * 400 * 10^{**3}) \\ &= 1/(17.6 * 10^{**-5}) \\ &= 5.68\text{K} \end{aligned}$$

The Rod and Rcmd should be adjusted in such a way that the effective pull-up is at the maximum 5.68K during enumeration. If there are only a few cards in the bus, a fixed Rcmd resistor is sufficient and there is no need for an additional

Rod pull-up during enumeration. You should also ensure the effective pull-up will not violate the I_{OL} rating of the drivers.

In SD mode, since each card has a separate bus, the capacitance is less, typically in the order of 20-30pf (host capacitance + card capacitance + trace + socket capacitance). For example, if enumeration is done at 400KHz and the total bus capacitance is 20pf, the pull-up needed during enumeration is:

$$\begin{aligned} 2.2 \text{ RC} &= \text{rise-time} = 1/400\text{KHz} \\ R &= 1/(2.2 * C * 100\text{KHz}) \\ &= 1/(2.2 \times 20 \times 10^{12} \times 400 \times 10^3) \\ &= 1/(1.76 \times 10^{12}) \\ &= 56.8\text{K} \end{aligned}$$

Therefore, a fixed 56.8K permanent Rcmd is sufficient in SD mode to enumerate the cards.

The driver of the SD/MMC Host Controller on the "command" port needs to be only a push-pull driver. During enumeration, the SD/MMC Host Controller emulates an open-drain driver by driving only a 0 or a "z" by controlling the ccmd_out and ccmd_out_en signals.

17.6.3 SD/MMC Controller IOMUX

The SDMMC Host Controller share the pin with GPIO. In default, the pins are used for GPIO, if user want to work in sdmmc function, the user must configure the GRF registers as following table:

Table 17- 4 SDMMC IOMUX Settings

Module Pin	Direction	Pad Name	IOMUX Setting
sdmmc_clkout	O	GPIO3_A[2]	GPIO3A_IOMUX[4]=0x1
sdmmc_cmd	I/O	GPIO3_A[3]	GPIO3A_IOMUX[6]=0x1
sdmmc_data0	I/O	GPIO3_A[4]	GPIO3A_IOMUX[8]=0x1
sdmmc_data1	I/O	GPIO3_A[5]	GPIO3A_IOMUX[10]=0x1
sdmmc_data2	I/O	GPIO3_A[6]	GPIO3A_IOMUX[12]=0x1
sdmmc_data3	I/O	GPIO3_A[7]	GPIO3A_IOMUX[14]=0x1
sdmmc_detect_n	I	GPIO3_B[0]	GPIO3B_IOMUX[0]=0x1
sdmmc_write_prt	I	GPIO3_B[1]	GPIO3B_IOMUX[2]=0x1
sdmmc_rstn_out	O	GPIO3_A[0]	GPIO3A_IOMUX[0]=0x1
sdmmc_pwr_en	O	GPIO3_A[1]	GPIO3A_IOMUX[2]=0x1

Notes: Direction: **I**- Input, **O**- Output, **I/O**- Input/Output

17.7 Application Notes

17.7.1 Software/Hardware Restriction

Before issuing a new data transfer command, the software should ensure that the card is not busy due to any previous data transfer command. Before changing the card clock frequency, the software must ensure that there are no data or command transfers in progress.

If the card is enumerated in SDR50, or DDR50 mode, then the application must program the use_hold_reg bit[29] in the CMD register to 1'b0 (phase shift of cclk_in_drv = 0) or 1'b1 (phase shift of cclk_in_drv > 0). If the card is enumerated in SDR12 or SDR25 mode, the application must program the use_hold_reg bit[29] in the CMD register to 1'b1.

This programming should be done for all data transfer commands and non-data commands that are sent to the card. When the use_hold_reg bit is

programmed to 1'b0, the SD/MMC Controller bypasses the Hold Registers in the transmit path. The value of this bit should not be changed when a Command or Data Transfer is in progress. For more details on using `use_hold_reg` and the implementation requirements for meeting the Card input hold time, refer to "Recommended Usage" and Table 17-5.

 Table 17-5 Recommended Usage of `use_hold_reg`

No.	Speed Mode	<code>use_hold_reg</code>	<code>cclk_in</code>	<code>clk_in_drv</code>	<code>clk_divider</code>
1	SDR50	1'b1	200	200	1
2	DDR50	1'b1	50	50	0
3	SDR25	1'b1	50	50	0
4	SDR12	1'b1	50	50	1

To avoid glitches in the card clock outputs (`sdmmc_clkout`), the software should use the following steps when changing the card clock frequency:

1. Before disable the clocks, ensure that the card is not busy due to any previous data command. To determine this, check for 0 in bit9 of STATUS register.
2. Update the Clock Enable register to disable all clocks. To ensure completion of any previous command before this update, send a command to the CIU to update the clock registers by setting:
 - `start_cmd` bit
 - "update clock registers only" bits
 - "wait_previous data complete" bit
 Wait for the CIU to take the command by polling for 0 on the `start_cmd` bit.
3. Set the `start_cmd` bit to update the Clock Divider and/or Clock Source registers, and send a command to the CIU in order to update the clock registers; wait for the CIU to take the command.
4. Set `start_cmd` to update the Clock Enable register in order to enable the required clocks and send a command to the CIU to update the clock registers; wait for the CIU to take the command.

In non-DMA mode, while reading from a card, the Data Transfer Over (RINTSTS[3]) interrupt occurs as soon as the data transfer from the card is over. There still could be some data left in the FIFO, and the RX_WMark interrupt may or may not occur, depending on the remaining bytes in the FIFO. Software should read any remaining bytes upon seeing the Data Transfer Over (DTO) interrupt. While using the external DMA interface for reading from a card, the DTO interrupt occurs only after all the data is flushed to memory by the DMA interface unit.

While writing to a card in external DMA mode, if an undefined-length transfer is selected by setting the Byte Count Register to 0, the DMA logic will likely request more data than it will send to the card, since it has no way of knowing at which point the software will stop the transfer. The DMA request stops as soon as the DTO is set by the CIU.

If the software issues a controller_reset command by setting control register bit[0] to 1, all the CIU state machines are reset; the FIFO is not cleared. The DMA sends all remaining bytes to the host. In addition to a card-reset, if a FIFO reset is also issued, then:

- Any pending DMA transfer on the bus completes correctly
- DMA data read is ignored
- Write data is unknown(x)

Additionally, if `dma_reset` is also issued, any pending DMA transfer is abruptly terminated. When the DW-DMA is used, the DMA controller channel should also

be reset and reprogrammed.

If any of the previous data commands do not properly terminate, then the software should issue the FIFO reset in order to remove any residual data, if any, in the FIFO. After asserting the FIFO reset, you should wait until this bit is cleared.

One data-transfer requirement between the FIFO and host is that the number of transfers should be a multiple of the FIFO data width (32bits). For example, you want to write only 15 bytes to an SDMMC card (BYTCNT), the host should write 16 bytes to the FIFO or program the DMA to do 16-byte transfers. The software can still program the Byte Count register to only 15, at which point only 15 bytes will be transferred to the card. Similarly, when 15 bytes are read from a card, the host should still read all 16 bytes from the FIFO.

It is recommended that you not change the FIFO threshold register in the middle of data transfers.

17.7.2 Programming Sequence

Initialization

Fig. 17-8 illustrates the initialization flow.

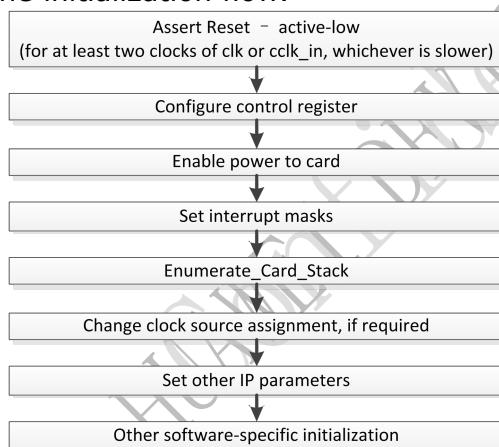


Fig. 17-8 Initialization Sequence

Once the power and clocks are stable, `reset_n` should be asserted(active-low) for at least two clocks of `clk` or `cclk_in`, whichever is slower. The reset initializes the registers, ports, FIFO-pointers, DMA interface controls, and state-machines in the design. After power-on reset, the software should do the following:

1. Configure control register – For MMC mode, enable the open-drain pullup by setting `enable_OD_pullup`(bit24) in the control register.
2. Enable power to cards – Before enabling the power, confirm that the voltage setting to the voltage regulators is correct. Enable power to the connected cards by setting the corresponding bit to 1 in the Power Enable register. Wait for the power ramp-up time.
3. Set masks for interrupts by clearing appropriate bits in the Interrupt Mask register. Set the global `int_enable` bit of the Control register. It is recommended that you write `0xffff_ffff` to the Raw Interrupt register in order to clear any pending interrupts before setting the `int_enable` bit.
4. Enumerate card stack – Each card is enumerated according to card type; for details, refer to “Enumerated Card Stack”. For enumeration, you should restrict the clock frequency to 400KHz.
5. Changing clock source assignment – set the card frequency using the clock-divider and clock-source registers; for details, refer to “Clock Programming”. MMC cards operate at a maximum of 20MHz (at maximum of 52MHz in high-speed mode). SD mode operates at a maximum of 25MHz (at maximum of 50MHz in high-speed mode).

6. Set other parameters, which normally do not need to be changed with every command, with a typical value such as timeout values in sdmmc_clkout according to SDMMC specifications.
 - ResponseTimeOut = 0x64
 - DataTimeOut = highest of one of the following:
 $(10*((TAAC*Fop)+(100*NSAC)))$
Host FIFO read/write latency from FIFO empty/full
 - Set the debounce value to 25ms(default:0xffff) in host clock cycle units in the DEBNCE register.
 - FIFO threshold value in bytes in the FIFOTH register. Typically, the threshold value can be set to half the FIFO depth; that is:
RX_WMark=15;
TX_WMark=16

Enumerated Card Stack

The card stack does the following:

- Enumerates all connected cards
- Sets the RCA for the connected cards
- Reads card-specific information
- Stores card-specific information locally

Enumeration depends on the operating mode of the SDMMC Host Controller; the card type is first identified and the appropriate card enumeration routine is called.

1. Check if the card is connected.
2. Clear the card type register to set the card width as a single bit. For the given card number, clear the corresponding bits in the card_type register. Clear the register bit for a 1-bit, 4-bit, or 8-bit bus width. For example, for card number=1, clear bit 0 and bit 16 of the card_type register.
3. Set clock frequency to Fod=400KHz, maximum – Program clock divider0 (bits 0-7 in the CLKDIV register) value to one-half of the cclk_in frequency divided by 400KHz. For example, if cclk_in is 20MHz, then the value is $20,000/(2*400)=25$.
4. Identify the card type; that is, SD, MMC, or SDIO.
 - a. Send CMD5 first. If a response is received, then the card is SDIO
 - b. If not, send CMD8 with the following Argument
Bit[31:12] = 20'h0 //reserved bits
Bit[11:8] = 4'b0001 //VHS value
Bit[7:0] = 8'b10101010 //Preferred Check Pattern by SD2.0
 - c. If Response is received the card supports High Capacity SD2.0 then send ACMD41 with the following Argument
Bit[31] = 1'b0; //Reserved bits
Bit[30] = 1'b1; //High Capacity Status
Bit[29:24] = 6'h0; //Reserved bits
Bit[23:0] = Supported Voltage Range
 - d. If Response is received for ACMD41 then the card is SD. Otherwise the card is MMC.
 - e. If response is not received for initial CMD8 then card does not support High Capacity SD2.0, then issue CMD0 followed by ACMD41 with the following Argument
Bit[31] = 1'b0; //Reserved bits
Bit[30] = 1'b0; //High Capacity Status
Bit[29:24] = 6'h0; //Reserved bits
Bit[23:0] = Supported Voltage Range

5. Enumerate the card according to the card type.
6. Use a clock source with a frequency = Fod (that is, 400KHz) and use the following enumeration command sequence:
 - SD card – Send CMD0, CMD8, ACMD41, CMD2, CMD3.
 - SDIO – Send CMD5, CMD3.
 - MMC – Send CMD0, CMD1, CMD2, CMD3.

Power Control

You can implement power control using the following registers, along with external circuitry:

- Control register bits card_voltage_a and card_voltage_b – Status of these bits is reflected at the IO pins. The bits can be used to generate or control the supply voltage that the memory cards require.
- Power enable register – Control power to individual cards.

Programming these two register depends on the implemented external circuitry. While turning on or off the power enable, you should confirm that power supply settings are correct. Power to all cards usually should be disable while switching off the power.

Clock Programming

The SDMMC controller supports four clock sources, each of which can be programmed with a different frequency; software can select the clock source for each card. The clock to an individual card can be enabled or disabled. Registers that support this are:

- CLKDIV – Programs individual clock source frequency.
- CLKSRC – Assign clock source for each card.
- CLKENA – Enables or disables clock for individual card and enables low-power mode, which automatically stops the clock to a card when the card is idle for more than 8 clocks.

The SDMMC Controller loads each of these registers only when the start_cmd bit and the Update_clk_regs_only bit in the CMD register are set. When a command is successfully loaded, the SDMMC Controller clears this bit, unless the SDMMC Controller already has another command in the queue, at which point it gives an HLE(Hardware Locked Error).

Software should look for the start_cmd and the Update_clk_regs_only bits, and should also set the wait_prvdata_complete bit to ensure that clock parameters do not change during data transfer. Note that even though start_cmd is set for updating clock registers, the SDMMC Controller does not raise a command_done signal upon command completion.

The following shows how to program these registers:

1. Confirm that no card is engaged in any transaction; if there is a transaction, wait until it finishes.
2. Stop all clocks by writing xxxx0000 to the CLKENA register. Set the start_cmd, Update_clk_regs_only, and wait_prvdata_complete bits in the CMD register. Wait until start_cmd is cleared or an HLE is set; in case of an HLE, repeat the command.
3. Program the CLKDIV and CLKSRC registers, as required. Set the start_cmd, Update_clk_regs_only, and wait_prvdata_complete bits in the CMD register. Wait until start_cmd is cleared or an HLE is set; in case of an HLE, repeat the command.
4. Re-enable all clocks by programming the CLKENA register. Set the start_cmd, Update_clk_regs_only, and wait_prvdata_complete bits in the CMD register. Wait until start_cmd is cleared or an HLE is set; in case of an HLE, repeat the command.

No-Data Command With or Without Response Sequence

To send any non-data command, the software needs to program the CMD register @0x2C and theCMDARG register @0x28 with appropriate parameters. Using these two registers, the SD/MMC controller forms the command and sends it to the command bus. The SD/MMC controller reflects the errors in the command response through the error bits of theRINTSTS register.

When a response is received – either erroneous or valid – the SD/MMC controller sets thecommand_done bit in the RINTSTS register. A short response is copied in Response Register0, while along response is copied to all four response registers @0x30, 0x34, 0x38, and 0x3C. The Response3register bit 31 represents the MSB, and the Response0 register bit 0 represents the LSB of a longresponse.

For basic commands or non-data commands, follow these steps:

1. Program the Command register @0x28 with the appropriate command argument parameter.
2. Program the Command register @0x2C with the settings in Table 17-6.

Table 17-6 Command Settings for No-Data Command

Parameter	Value	Description
Default		
start_cmd	1	-
use_hold_reg	1/0	Choose value based on speed mode being used;ref to “use_hold_reg” on CMD register
Update_clk_regs_only	0	No clock parameters update command
data_expected	0	No data command
card number	0	Actual card number(one controller only connect one card, the num is No.0)
cmd_index	command-index	-
send_initialization	0	Can be 1, but only for card reset commands, such as CMD0
stop_abort_cmd	0	Can be 1 for commands to stop data transfer, such as CMD12
response_length	0	Can be 1 for R2(long) response
response_expect	1	Can be 0 for commands with no response; for example, CMD0, CMD4, CMD15, and so on
User-selectable		
wait_prvdata_complete	1	Before sending command on command line, host should wait for completion of any data command in process, if any (recommended to always set this bit, unless the current command is to query status or stop data transfer when transfer is in progress)
check_response_crc	1	If host should crosscheck CRC of response received

3. Wait for command acceptance by host. The following happens when the command is loaded intothe SD/MMC controller:
 - SD/MMC controller accepts the command for execution and clears the start_cmd bit in theCMD register, unless one command is in process, at which point the SD/MMC controller can load and keep the second command in the buffer.

- If the SD/MMC controller is unable to load the command – that is, a command is already in progress, a second command is in the buffer, and a third command is attempted – then it generates an HLE (hardware-locked error).
4. Check if there is an HLE.
 5. Wait for command execution to complete. After receiving either a response from a card or response timeout, the SD/MMC controller sets the command_done bit in the RINTSTS register. Software can either poll for this bit or respond to a generated interrupt.
 6. Check if response_timeout error, response_CRC error, or response error is set. This can be done either by responding to an interrupt raised by these errors or by polling bits 1, 6, and 8 from the RINTSTS register @0x44. If no response error is received, then the response is valid. If required, the software can copy the response from the response registers @0x30-0x3C.

Software should not modify clock parameters while a command is being executed.

Data Transfer Commands

Data transfer commands transfer data between the memory card and the SD/MMC controller. To send a data command, the SD/MMC controller needs a command argument, total data size, and block size. Software can receive or send data through the FIFO.

Before a data transfer command, software should confirm that the card is not busy and is in a transfer state, which can be done using the CMD13 and CMD7 commands, respectively.

For the data transfer commands, it is important that the same bus width that is programmed in the card should be set in the card type register @0x18. The SD/MMC controller generates an interrupt for different conditions during data transfer, which are reflected in the RINTSTS register @0x44 as:

1. Data_Transfer_Over (bit 3) – When data transfer is over or terminated. If there is a response timeout error, then the SD/MMC Host Controller does not attempt any data transfer and the “Data Transfer Over” bit is never set.
2. Transmit_FIFO_Data_request (bit 4) – FIFO threshold for transmitting data was reached; software is expected to write data, if available, in FIFO.
3. Receive_FIFO_Data_request (bit 5) – FIFO threshold for receiving data was reached; software is expected to read data from FIFO.
4. Data starvation by Host timeout (bit 10) – FIFO is empty during transmission or is full during reception. Unless software writes data for empty condition or reads data for full condition, the SD/MMC controller cannot continue with data transfer. The clock to the card has been stopped.
5. Data read timeout error (bit 9) – Card has not sent data within the timeout period.
6. Data CRC error (bit 7) – CRC error occurred during data reception.
7. Start bit error (bit 13) – Start bit was not received during data reception.
8. End bit error (bit 15) – End bit was not received during data reception or for a write operation; a CRC error is indicated by the card.

Conditions 6, 7, and 8 indicate that the received data may have errors. If there was a response timeout, then no data transfer occurred.

Single-Block or Multiple-Block Read

Steps involved in a single-block or multiple-block read are:

1. Write the data size in bytes in the BYTCNT register @0x20.
2. Write the block size in bytes in the BLKSIZ register @0x1C. The SD/MMC controller expects data from the card in blocks of size BLKSIZ each.
3. Program the CMDARG register @0x28 with the data address of the beginning of a data read.

Program the Command register with the parameters listed in Table 17-7. For SD and MMC cards, use CMD17 for a single-block read and CMD18 for a multiple-block read. For SDIO cards, use CMD53 for both single-block and multiple-block transfers.

Table 17-7 Command Setting for Single-Block or Multiple-Block Read

Parameter	Value	Description
Default		
start_cmd	1	-
use_hold_reg	1/0	Choose value based on speed mode being used; ref to "use_hold_reg" on CMD register
Update_clk_regs_only	0	No clock parameters update command
card number	0	Actual card number (one controller only connect one card, the num is No.0)
send_initialization	0	Can be 1, but only for card reset commands, such as CMD0
stop_abort_cmd	0	Can be 1 for commands to stop data transfer, such as CMD12
send_auto_stop	0 or 1	Set according to Table xx
transfer_mode	0	Block transfer
read_write	0	Read from card
data_expected	1	Data command
response_length	0	Can be 1 for R2(long) response
response_expect	1	Can be 0 for commands with no response; for example, CMD0, CMD4, CMD15, and so on
User-selectable		
cmd_index	command_index	-
wait_prvdata_complete	1	0- Sends command immediately 1- Sends command after previous data transfer ends
check_response_crc	1	0- SD/MMC controller should not check response CRC 1- SD/MMC controller should check response CRC

After writing to the CMD register, the SD/MMC controller starts executing the command; when the command is sent to the bus, the command_done interrupt is generated.

4. Software should look for data error interrupts; that is, bits 7, 9, 13, and 15 of the RINTSTS register. If required, software can terminate the data transfer by sending a STOP command.
5. Software should look for Receive_FIFO_Data_request and/or data starvation by host timeout conditions. In both cases, the software should read data from the FIFO and make space in the FIFO for receiving more data.
6. When a Data_Transfer_Over interrupt is received, the software should read the remaining data from the FIFO.

Single-Block or Multiple-Block Write

Steps involved in a single-block or multiple-block write are:

1. Write the data size in bytes in the BYTCNT register @0x20.
2. Write the block size in bytes in the BLKSIZ register @0x1C; the SD/MMC controller sends data in blocks of size BLKSIZ each.
3. Program CMDARG register @0x28 with the data address to which data should be written.
4. Write data in the FIFO; it is usually best to start filling data the full depth of the FIFO.
5. Program the Command register with the parameters listed in Table 17-8. For SD and MMC cards, use CMD24 for a single-block write and CMD25 for a multiple-block write. For SDIO cards, use CMD53 for both single-block and multiple-block transfers.

Table 17-8 Command Settings for Single-Block or Multiple-Block Write

Parameter	Value	Description
Default		
start_cmd	1	-
use_hold_reg	1/0	Choose value based on speed mode being used; ref to "use_hold_reg" on CMD register
Update_clk_regs_only	0	No clock parameters update command
card number	0	Actual card number(one controller only connect one card, the num is No.0)
send_initialization	0	Can be 1, but only for card reset commands, such as CMD0
stop_abort_cmd	0	Can be 1 for commands to stop data transfer, such as CMD12
send_auto_stop	0 or 1	Set according to Table xx
transfer_mode	0	Block transfer
read_write	1	Write to card
data_expected	1	Data command
response_length	0	Can be 1 for R2(long) response
response_expect	1	Can be 0 for commands with no response; for example, CMD0, CMD4, CMD15, and so on
User-selectable		
cmd_index	command_index	-
wait_prvdata_complete	1	0- Sends command immediately 1- Sends command after previous data transfer ends
check_response_crc	1	0- SD/MMC controller should not check response CRC 1- SD/MMC controller should check response CRC

After writing to the CMD register, SD/MMC controller starts executing a command; when the command is sent to the bus, a command_done interrupt is generated.

6. Software should look for data error interrupts; that is, for bits 7, 9, and 15 of the RINTSTS register. If required, software can terminate the data transfer by sending the STOP command.
7. Software should look for Transmit_FIFO_Data_request and/or timeout conditions from data starvation by the host. In both cases, the software should write data into the FIFO.

8. When a Data_Transfer_Over interrupt is received, the data command is over. For an open-ended block transfer, if the byte count is 0, the software must send the STOP command. If the byte count is not 0, then upon completion of a transfer of a given number of bytes, the SD/MMC Host Controller should send the STOP command, if necessary. Completion of the AUTO-STOP command is reflected by the Auto_command_done interrupt – bit 14 of the RINTSTS register. A response to AUTO_STOP is stored in RESP1 @0x34.

Stream Read

A stream read is like the block read mentioned in "Single-Block or Multiple-Block Read", except for the following bits in the Command register:

```
transfer_mode = 1; //Stream transfer
```

```
cmd_index = CMD20;
```

A stream transfer is allowed for only a single-bit bus width.

Stream Write

A stream write is exactly like the block write mentioned in "Single-Block or Multiple-Block Write", except for the following bits in the Command register:

```
transfer_mode = 1;//Stream transfer
```

```
cmd_index = CMD11;
```

In a stream transfer, if the byte count is 0, then the software must send the STOP command. If the bytecount is not 0, then when a given number of bytes completes a transfer, the SD/MMC controller sends the STOP command.

Completion of this AUTO_STOP command is reflected by theAuto_command_done interrupt. A response to an AUTO_STOP is stored in the RESP1 register@0x34.

A stream transfer is allowed for only a single-bit bus width.

Sending Stop or Abort in Middle of Transfer

The STOP command can terminate a data transfer between a memory card and theSD/MMC controller, while the ABORT command can terminate an I/O data transfer for only the SDIO_IOONLY and SDIO_COMBO cards.

- Send STOP command – Can be sent on the command line while a data transfer is in progress; this command can be sent at any time during a data transfer. For information on sending this command, refer to "No-Data Command With or Without Response Sequence". You can also use an additional setting for this command in order to set the Command register bits (5-0) to CMD12 and set bit 14 (stop_abort_cmd) to 1. If stop_abort_cmd is not set to 1, the SD/MMC controller does not know that the user stopped a data transfer. Reset bit 13 of the Command register (wait_prvdata_complete) to 0 in order to make the SD/MMC controller sendthe command at once, even though there is a data transfer in progress.
- Send ABORT command – Can be used with only an SDIO_IOONLY or SDIO_COMBO card. To abort the function that is transferring data, program the function number in ASx bits (CCCR register of card, address 0x06, bits (0-2) using CMD52.

This is a non-data command. For information on sending this command, refer to "No-Data Command With or Without Response Sequence".

The command format for CMD52 is illustrated in Fig. 17-9:

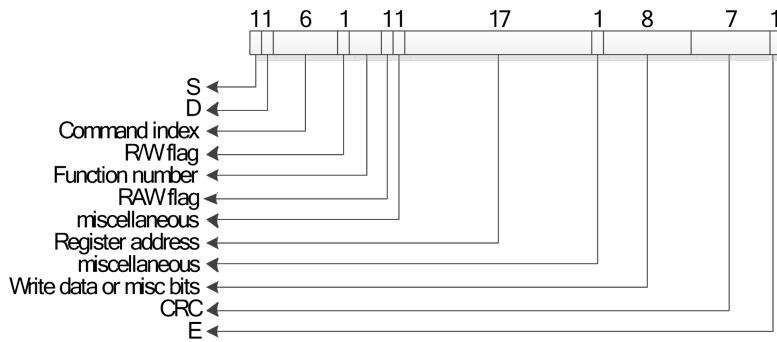


Fig. 17-9 Command format for CMD52

- Program the CMDARG register @0x28 with the appropriate command argument parameters listed in [Table 17-9](#).

Table 17-9 Parameters for CMDARG Registers

CMDARG Bits	Contents	Value
31	R/W flag	1
30-28	Function Number	0, for CCCR access
27	RAW flag	1, if needed to read after write
26	Don't care	-
25-9	Register address	0x06
8	Don't care	-
7-0	Write Data	Function number to be aborted

- Program the Command register using the command index as CMD52. Similar to the STOP command described, set bit 14 of the Command register (stop_abort_cmd) to 1, which must be done in order to inform the SD/MMC controller that the user aborted the data transfer. Reset bit 13 (wait_prvdata_complete) of the Command register to 0 in order to make the SD/MMC controller send the command at once, even though a data transfer is in progress.
- Wait for command_transfer_over.
- Check response (R5) for errors.

Suspend or Resume Sequence

In an SDIO card, the data transfer between an I/O function and the SD/MMC controller can be temporarily halted using the SUSPEND command; this may be required in order to perform a high-priority data transfer with another function. When desired, the data transfer can be resumed using the RESUME command.

The following functions can be implemented by programming the appropriate bits in the CCCR register (Function 0) of the SDIO card. To read from or write to the CCCR register, use the CMD52 command.

- SUSPEND data transfer – Non-data command.
 - Check if the SDIO card supports the SUSPEND/RESUME protocol; this can be done through the SBS bit in the CCCR register @0x08 of the card.
 - Check if the data transfer for the required function number is in process; the function number that is currently active is reflected in bits 0-3 of the CCCR register @0x0D. Note that if the BS bit (address 0xc::bit 0) is 1, then only the function number given by the FSx bits is valid.
 - To suspend the transfer, set BR (bit 2) of the CCCR register @0x0C.
 - Poll for clear status of bits BR (bit 1) and BS (bit 0) of the CCCR @0x0C.

- The BS (Bus Status) bit is 1 when the currently-selected function is using the data bus; the BR (Bus Release) bit remains 1 until the bus release is complete. When the BR and BS bits are 0, the data transfer from the selected function has been suspended.
- e. During a read-data transfer, the SD/MMC controller can be waiting for the data from the card. If the data transfer is a read from a card, then the SD/MMC controller must be informed after the successful completion of the SUSPEND command. The SD/MMC controller then resets the data state machine and comes out of the wait state. To accomplish this, set abort_read_data (bit 8) in the Control register.
 - f. Wait for data completion. Get pending bytes to transfer by reading the TCBCNT register @0x5C.
2. RESUME data transfer – This is a data command.
 - a. Check that the card is not in a transfer state, which confirms that the bus is free for data transfer.
 - b. If the card is in a disconnect state, select it using CMD7. The card status can be retrieved in response to CMD52/CMD53 commands.
 - c. Check that a function to be resumed is ready for data transfer; this can be confirmed by reading the RFx flag in CCCR @0x0F. If RF = 1, then the function is ready for data transfer.
 - d. To resume transfer, use CMD52 to write the function number at FSx bits (0-3) in the CCCR register @0x0D. Form the command argument for CMD52 and write it in CMDARG @0x28; bit values are listed in Table 17-10.

Table 17- 10 CMDARG Bit Values

CMDARG Bits	Contents	Value
31	R/W flag	1
30-28	Function Number	0, for CCCR access
27	RAW flag	1, read after write
26	Don't care	-
25-9	Register address	0x0D
8	Don't care	-
7-0	Write Data	Function number to be resumed

- e. Write the block size in the BLKSIZ register @0x1C; data will be transferred in units of this block size.
- f. Write the byte count in the BYTCNT register @0x20. This is the total size of the data; that is, the remaining bytes to be transferred. It is the responsibility of the software to handle the data.
- g. Program Command registers; similar to a block transfer. For details, refer to "Single-Block or Multiple-Block Read" and "Single-Block or Multiple-Block Write".
- h. When the Command register is programmed, the command is sent and the function resumes data transfer. Read the DF flag (Resume Data Flag). If it is 1, then the function has data for the transfer and will begin a data transfer as soon as the function or memory is resumed. If it is 0, then the function has no data for the transfer.
- i. If the DF flag is 0, then in case of a read, the SD/MMC Host Controller waits for data. After the data timeout period, it gives a data timeout error.

Read Wait Sequence

Read_wait is used with only the SDIO card and can temporarily stall the data transfer—either from function or memory—and allow the host to send commands

to any function within the SDIO device. The host can stall this transfer for as long as required. The SD/MMC Host Controller provides the facility to signal this stall transfer to the card. The steps for doing this are:

1. Check if the card supports the read_wait facility; read SRW (bit 2) of the CCCR register @0x08. If this bit is 1, then all functions in the card support the read_wait facility. Use CMD52 to read this bit.
2. If the card supports the read_wait signal, then assert it by setting the read_wait (bit 6) in the CTRL register @0x00.
3. Clear the read_wait bit in the CTRL register.

Controller/DMA/FIFO Reset Usage

Communication with the card involves the following:

- Controller – Controls all functions of the SD/MMC controller.
- FIFO – Holds data to be sent or received.
- DMA – If DMA transfer mode is enabled, then transfers data between system memory and the FIFO.
- Controller reset – Resets the controller by setting the controller_reset bit (bit 0) in the CTRL register; this resets the CIU and state machines, and also resets the BIU-to-CIU interface. Since this reset bit is self-clearing, after issuing the reset, wait until this bit is cleared.
- FIFO reset – Resets the FIFO by setting the fifo_reset bit (bit 1) in the CTRL register; this resets the FIFO pointers and counters of the FIFO. Since this reset bit is self-clearing, after issuing the reset, wait until this bit is cleared.
- DMA reset – Resets the internal DMA controller logic by setting the dma_reset bit (bit 2) in the CTRL register, which abruptly terminates any DMA transfer in process. Since this reset bit is self-clearing, after issuing the reset, wait until this bit is cleared.

The following are recommended methods for issuing reset commands:

- Non-DMA transfer mode – Simultaneously sets controller_reset and fifo_reset; clears the RAWINTS register @0x44 using another write in order to clear any resultant interrupt.
- DMA mode – Sets controller_reset and fifo_reset; waits until dma_req goes inactive (the Status register indicates the value of this signal). Resets the FIFO again. Clears the interrupts by clearing the RAWINTS register @0x44 using another write in order to clear any resultant interrupt. You also need to reset and reprogram the channel(s) of the DMA controller that are interfaced to the SD/MMC Host Controller.

In external DMA transfer mode, even when the FIFO pointers are reset, if there is a DMA transfer in progress, it could push or pop data to or from the FIFO; the DMA itself completes correctly. In order to clear the FIFO, the software should issue an additional FIFO reset and clear any FIFO underrun or overrun errors in the RAWINTS register caused by the DMA transfers after the FIFO was reset.

Error Handling

The SD/MMC controller implements error checking; errors are reflected in the RAWINTS register @0x44 and can be communicated to the software through an interrupt, or the software can poll for these bits. Upon power-on, interrupts are disabled (int_enable in the CTRL register is 0), and all the interrupts are masked (bits 0-31 of the INTMASK register; default is 0).

Error handling:

- Response and data timeout errors – For response timeout, software can retry the command. For data timeout, the SD/MMC controller has not received the data start bit – either for the first block or the intermediate block – within the timeout period, so software can either retry the whole data transfer again or retry from a specified block onwards. By reading the contents of the TCBCNT later, the software can decide how many bytes remain to be copied.
- Response errors – Set when an error is received during response reception. In this case, the response that copied in the response registers is invalid. Software can retry the command.
- Data errors – Set when errors in data reception are observed; for example, data CRC, start bit not found, end bit not found, and so on. These errors could be set for any block – first block, intermediate block, or last block. On receipt of an error, the software can issue a STOP or ABORT command and retry the command for either whole data or partial data.
- Hardware locked error – Set when the SD/MMC controller cannot load a command issued by software. When software sets the start_cmd bit in the CMD register, the SD/MMC controller tries to load the command. If the command buffer is already filled with a command, this error is raised. The software then has to reload the command.
- FIFO underrun/overrun error – If the FIFO is full and software tries to write data in the FIFO, then an overrun error is set. Conversely, if the FIFO is empty and the software tries to read data from the FIFO, an underrun error is set. Before reading or writing data in the FIFO, the software should read the fifo_empty or fifo_full bits in the Status register.
- Data starvation by host timeout – Raised when the SD/MMC controller is waiting for software intervention to transfer the data to or from the FIFO, but the software does not transfer within the stipulated timeout period. Under this condition and when a read transfer is in process, the software should read data from the FIFO and create space for further data reception. When a transmit operation is in process, the software should fill data in the FIFO in order to start transferring data to the card.
- CRC Error on Command – If a CRC error is detected for a command, the CE-ATA device does not send a response, and a response timeout is expected from the SD/MMC controller. The ATA layer is notified that an MMC transport layer error occurred.

Notes: During a multiple-block data transfer, if a negative CRC status is received from the device, the data path signals a data CRC error to the BIU by setting the data CRC error bit in the RINTSTS register. It then continues further data transmission until all the bytes are retransmitted.

17.7.3 Programming SD/MMC Controller for Boot Operation

Boot Operation

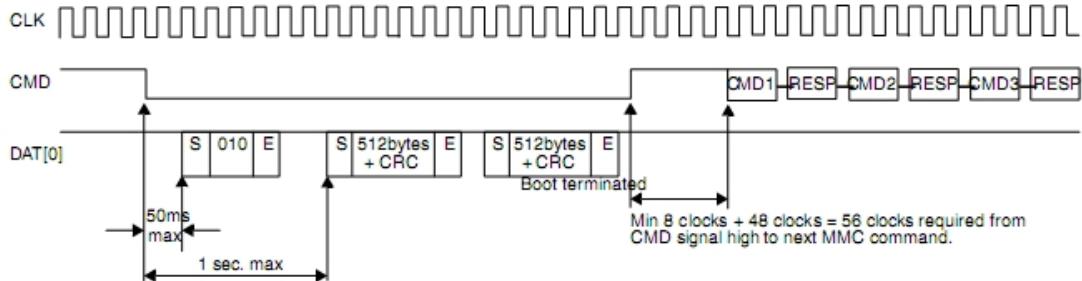


Fig. 17-10 Boot Operation

Fig. 17-10 illustrates timing for Boot operation.

Once the power and clocks are stable, reset_n should be asserted (active-low) for at least two clocks of clk or cclk_in, whichever is slower. The reset initializes the following:

- Registers
- Ports
- FIFO-pointers
- DMA interface controls
- State-machines in the design

After power-on reset, the software should perform the appropriate steps described in the following sections for the respective types of cards.

Following are the steps that the software driver must follow when working with eMMC cards for Boot operation.

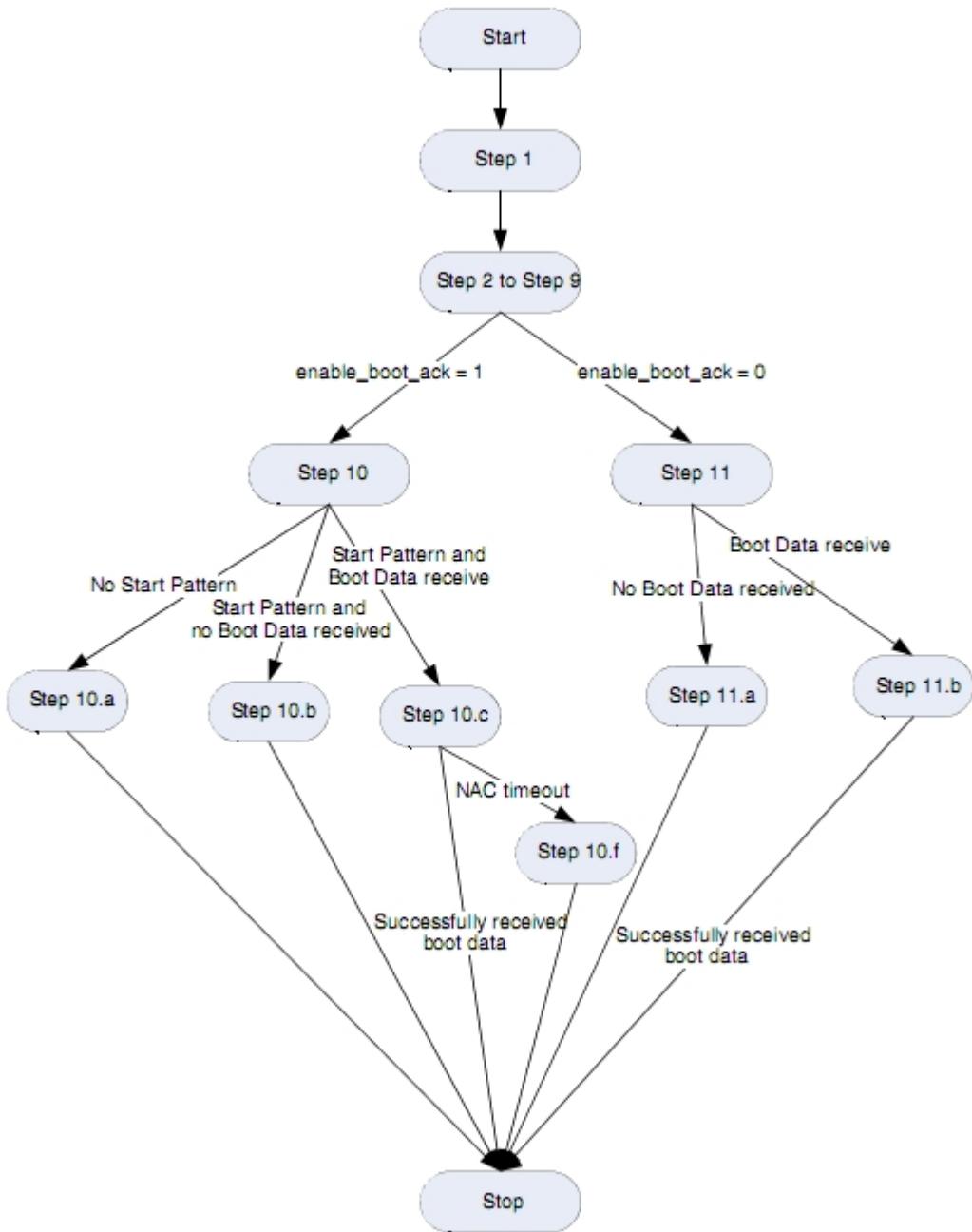


Fig. 17-11 SD/MMC Controller Flow for Boot Operation

1. The software driver is aware:
 - That the card supports boot operation—BOOT_PARTITION_ENABLE bit set in the card.
 - Of the BOOT_SIZE_MULT value in the card and the data bus width to use during boot operation—Extend CSD register byte[177] bit[0:1].
2. Set the following:
 - Masks for interrupts by clearing appropriate bits in the Interrupt Mask register @0x024.
 - Global int_enable bit of the Control register @0x00.

It is recommended that you write 0xffff_ffff to the Raw Interrupt register @0x044 and IDSTS @0x8C in order to clear any pending interrupts before

setting the int_enable bit.

For Internal DMAC mode, the software driver needs to unmask all the relevant fields in the IDINTEN register.

3. Configure control register (CTRL):
 - int_enable = 1'b1
 - Other fields should be 1'b0.
 4. Change clock source assignment – Set the card frequency to 400 KHz using the clock-divider and clock-source registers; for details, refer to “Clock Programming”.
 5. Set DataTimeOut = $(10 * ((TAAC * Fop) + (100 * NSAC)))$; this is NAC.
 6. Program the BLKSIZ register with 0x200 (512 bytes).
 7. Program the BYTCNT register with multiples of 128K bytes, as indicated by the BOOT_SIZE_MULT value in the card.
 8. Program the Rx FIFO threshold value in bytes in the FIFOTH register @0x04C. Typically, the threshold value can be set to half the FIFO depth; that is, RX_WMark = $(\text{FIFO_DEPTH}/2) - 1$.
 9. Program the CMD register with the following fields:
 - start_cmd = 1'b1
 - enable_boot = 1'b1
 - enable_boot_ack – depends on whether a start-acknowledge pattern is expected from the card
 - Card_number = appropriate_card_number; obtained by referring to CDETECT register
 - Data_expected = 1'b1
 - Remainder of CMD register fields = 1'b0
 10. If enable_boot_ack = 1'b1, the software driver should start a timer after step #9; the terminal value is 50ms.
 - Before this timer elapses, the BAR interrupt should be received from the SD/MMC Controller. If this does not occur, the software driver must program the CMD register with the following fields:
 - start_cmd = 1'b1
 - disable_boot = 1'b1
 - All other fields = 0
- The SD/MMC Controller generates a Command Done (CD) interrupt after de-asserting the CMD line of the card.
- If the BAR interrupt is received, the software driver should clear this interrupt by writing a 1 to it. The software driver should then start another timer with a terminal value of $1 - 0.05 = 0.95$ seconds. Before this timer elapses, the BDS interrupt should be received from the SD/MMC Controller. If this does not occur, the software driver must program the CMD register with the following fields:
 - start_cmd = 1'b1
 - disable_boot = 1'b1
 - All other fields = 0

The SD/MMC Controller generates a Command Done (CD) interrupt after de-asserting the CMD line of the card.

- If the BDS interrupt is received, it indicates that the boot data is being received from the card. The software driver can then initiate a data read from the SD/MMC Controller based on the RXDR interrupt bit in the RINTSTS register. At the end of a successful boot data transfer from the card, the following interrupts are generated:
 - Command Done (CD) in RINTSTS register
 - Data Transfer Over (DTO) in RINTSTS register
- If an Error occurs in Boot Ack pattern (010) or an end bit Error occurs:
 - RTL automatically aborts boot by pulling CMD line high
 - RTL generates Command done interrupt
 - RTL does not generate BAR interrupt
 - Application aborts boot transfer
- If between data block transfers NAC is violated, DRTO (Data Read Timeout) is asserted. Apart from this, if there are errors associated with Start/End bits, SBE/EBE interrupts are also generated.

11. If enable_boot_ack = 1'b0, the software driver should start a timer after the step #9 where the terminal value is 1 second.

- Before this timer elapses, a BDS interrupt should be received from the SD/MMC Controller. If this does not occur, the software driver must program the CMD register with the following fields:
 - start_cmd = 1'b1
 - disable_boot = 1'b1
 - All other fields = 0

The SD/MMC Controller generates a Command Done (CD) interrupt after de-asserting the CMD line of the card.

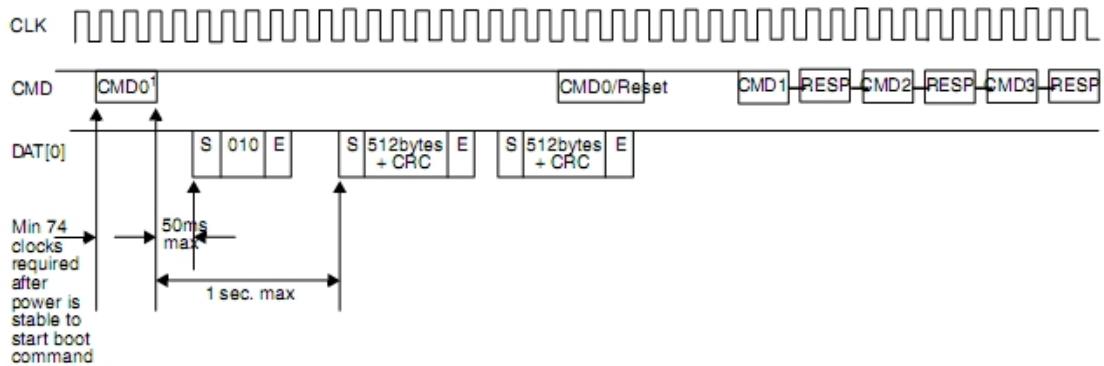
- If a BDS interrupt is received, it indicates that the boot data is being received from the card. The software driver can then initiate a data read from the SD/MMC Controller based on the RXDR interrupt bit in the RINTSTS register.

At the end of a successful boot data transfer from card, the following interrupts are generated.

- Command Done (CD) in RINTSTS.
- Data Transfer Over (DTO) in RINTSTS.

Alternative Boot Operation

The Alternative Boot Operation differs from the Boot Operation in that CMD0 is used to boot the card rather than holding down the CMD-line of the card. The Alternative Boot Operation can be done only if bit 0 in the extended CSD byte[228] (BOOT_INFO) is set to 1.



1. CMD0 with argument 0xFFFFFFFFA

Fig. 17- 12 Alternative Boot Operation

Following are the steps that the software driver must follow when working with eMMC for the Alternative Boot operation.

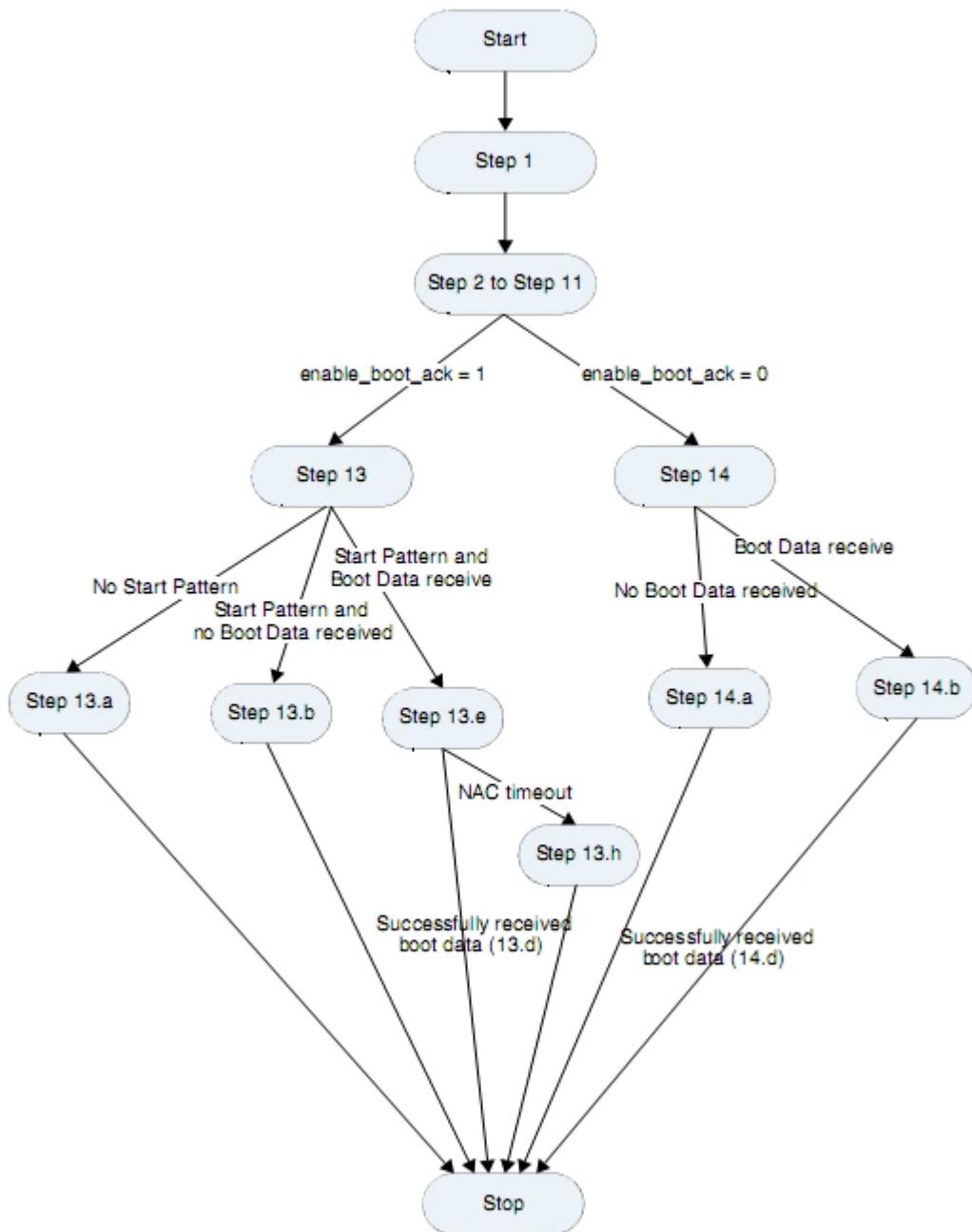


Fig. 17-13 Host Controller Flow for Alternative Boot Mode

1. The software driver is aware:
 - That the card supports the Alternative Boot operation—BOOT_INFO bit is set in the card.
 - Of the BOOT_SIZE_MULT value in the card and the data bus width to use during the boot operation—Extend CSD register byte[177] bit[0:1].
2. Set the following:
 - Masks for interrupts by clearing appropriate bits in the Interrupt Mask register @0x024
 - Global int_enable bit of the Control register @0x00

It is recommended that you write 0xffff_ffff to the Raw Interrupt register @0x044 and IDSTS @0x8C in order to clear any pending interrupts

before setting the int_enable bit.

For Internal DMAC mode, software driver needs to unmask all the relevant fields in IDINTEN register.

3. Configure control register (CTRL):
 - enable_OD_pullup = 1'b0
 - int_enable = 1'b1
 - Other fields should be 1'b0
4. Changing clock source assignment – Set the card frequency to 400 KHz using the clock-divider and clock-source registers; for details, refer to “Clock Programming”. Ensure that the card clock—cclk_out—is running.
5. Wait for a time that ensures that at least 74 card clock cycles have occurred on the card interface.
6. Set DataTimeOut = $(10 * ((TAAC * Fop) + (100 * NSAC)))$; this is NAC.
7. Program the BLKSIZ register with 0x200–512 bytes.
8. Program the BYTCNT register with multiples of 128K bytes, as indicated by the BOOT_SIZE_MULT value in the card.
9. Program the Rx FIFO threshold value in bytes in the FIFOTH register @0x04C. Typically, the threshold value can be set to half the FIFO depth; that is, RX_WMark = (FIFO_DEPTH/2) - 1.
10. Program CMDARG = 0xFFFFFFFF.
11. Program the CMD register with the following fields.
 - start_cmd = 1'b1
 - boot_mode = 1'b1
 - enable_boot_ack – depends on whether a start-acknowledge pattern is expected from the card.
 - Card_number – appropriate_card_number, obtained by referring to CDETECT register
 - Data_expected = 1'b1
 - Cmd_index = 0
 - Remainder of CMD register fields = 1'b0
12. The software driver should wait for the Command Done (CD) interrupt.
13. If enable_boot_ack = 1'b1 in step 11, the software driver should start a timer after the above step with a terminal value of 50ms.
 - Before this timer elapses, the BAR interrupt should be received from the SD/MMC Controller. If this does not occur, the software driver needs to infer that the start-pattern has not been received and should discontinue the boot process and start with normal enumeration.
 - If the BAR interrupt is received, the software driver should clear this interrupt by writing a 1 to it. The software driver should then start another timer with a terminal value of $1 - 0.05 = 0.95$ seconds. Before this timer elapses, the BDS interrupt should be received from the SD/MMC Controller. If this does not occur, the software driver should discontinue the boot process and start with normal enumeration.
 - If the BDS interrupt is received, it indicates that the boot data is being received from the card. In non-IDMAC mode, the software driver can then initiate a data read from the SD/MMC Controller based on the RXDR interrupt bit in the RINTSTS register.
 - It is the responsibility of the software driver to terminate the boot operation by programming the SD/MMC Controller to send a CMD0 by programming the registers CMDARG = 0 and CMD = {start_cmd = 1, card number = appropriate_card_number, cmd_index = 0, all_other_fields = 0}.

- At the end of a successful boot data transfer from the card, the following interrupts are:
 - Command Done (CD) in RINTSTS
 - Data Transfer Over (DTO) in RINTSTS
 - Receive Interrupt (RI) in IDSTS in IDMAC mode only
 - If an Error occurs in Boot Ack pattern (010) or an end bit Error occurs:
 - RTL does not generate BAR interrupt
 - RTL detects Boot Data Start and generates BDS interrupt
 - RTL continues to receive Boot Data
 - Application must abort boot after receiving BDS interrupt
 - If between data block transfers NAC is violated, DRTO (Data Read Timeout) is asserted. Apart from this, if there are errors associated with Start/End bits, SBE/EBE interrupts are also generated.
14. If enable_boot_ack = 1'b0 in step 11, the software driver should start a timer after step #11 with a terminal value of 1 second.
- Before this timer elapses, the BDS interrupt should be received from the SD/MMC Controller. If this does not occur, the software driver should discontinue the boot process and start with normal enumeration.
 - If the BDS interrupt is received, it indicates that the boot data is being received from the card. In non-IDMAC mode, the software driver can then initiate a data read from the SD/MMC Controller based on the RXDR (in RINTSTS) interrupt.
 - It is the responsibility of the software driver to terminate the boot operation by programming the SD/MMC Controller to send a CMD0 by programming the registers CMDARG = 0 and CMD = {start_cmd=1, card number = appropriate card number, cmd_index =0, rest of the fields = 0}.
 - At the end of a successful boot data transfer from card, the following interrupts are generated.
 - Command Done (CD) in RINTSTS.
 - Data Transfer Over (DTO) in RINTSTS.
 - Receive Interrupt (RI) in IDSTS in IDMAC mode only.

17.7.4 Voltage Switching and DDR Operations

Voltage Switch Operation

The Voltage Switch operation must be performed in SD mode only.

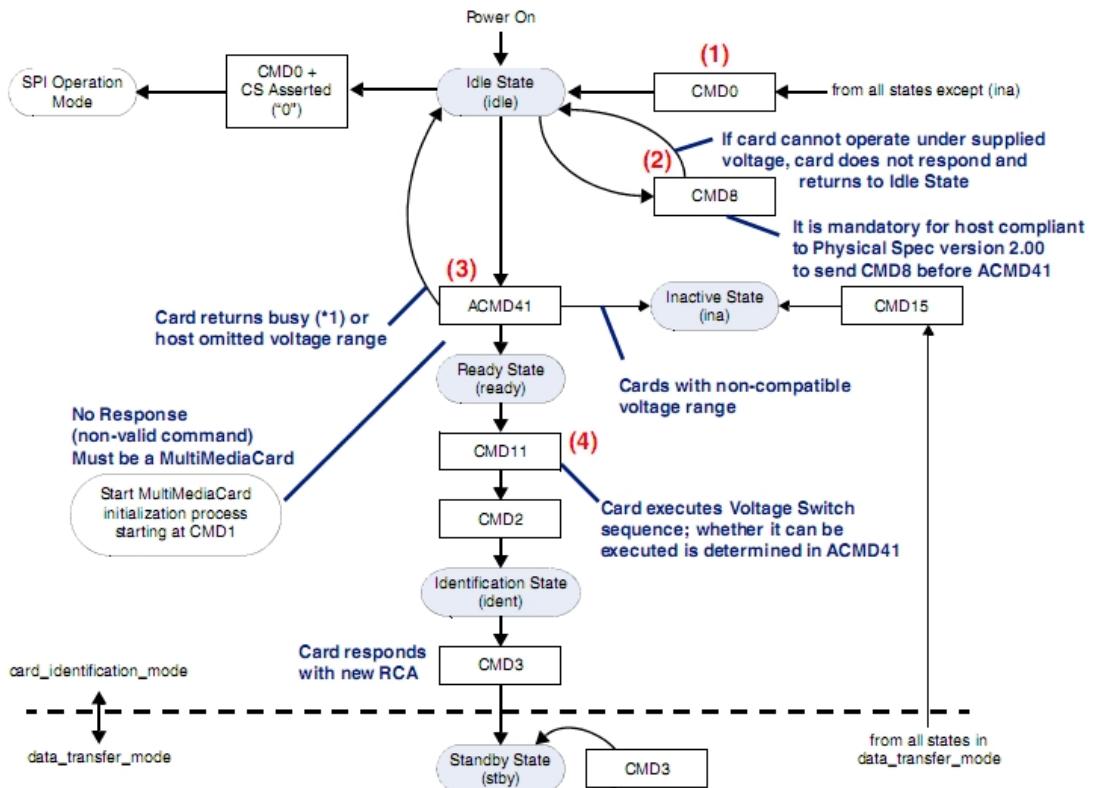


Fig. 17-14 Voltage Switching Command Flow Diagram

The following outlines the steps for the voltage switch programming sequence

1. Software Driver starts CMD0, which selects the bus mode as SD.
2. After the bus is in SD card mode, CMD8 is started in order to verify if the card is compatible with the SD Memory Card Specification, Version 2.00. CMD8 determines if the card is capable of working within the host supply voltage specified in the VHS (19:16) field of the CMD; the card supports the current host voltage if a response to CMD8 is received.
3. ACMD 41 is started. The response to this command informs the software if the card supports voltage switching; bits 38, 36, and 32 are checked by the card argument of ACMD41; refer to Figure 17-15.

47	46	45-40	39	38	37	36	35-33	32	31-16	15-08	07-01	00
S	D	Index	Busy 31	HCS 30	(FB) 29	XPC 28	Reserved 27-25	S18R 24	OCR 23-08	Reserved 07-00	CRC7	E
0	1	101001	0	X	0	X	000	X	xxxxh	0000000	xxxxxx	1

Annotations below the table:

- Host Capacity Support: 0b: SDSC-only Host, 1b: SDHC or SDXC supported
- SCXC Power Control: 0b: Power saving, 1b: Maximum performance
- S18R: Switching to 1.8V Request: 0b: Use current signal voltage, 1b: Switch to 1.8V signal voltage

Fig. 17-15 ACMD41 Argument

- Bit 30 informs the card if host supports SDHC/SDXC or not; this bit should be set to 1'b1.
- Bit 28 can be either 1 or 0.
- Bit 24 should be set to 1'b1, indicating that the host is capable of voltage switching; refer to Figure 17-16.

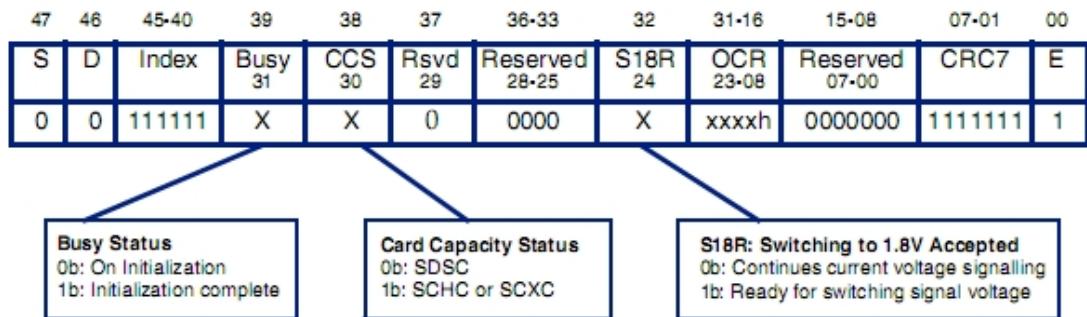


Fig. 17- 16 ACMD41 Response(R3)

- Bit 30 – If set to 1'b1, card supports SDHC/SDXC; if set to 1'b0, card supports only SDSC
 - Bit 24 – If set to 1'b1, card supports voltage switching and is ready for the switch
 - Bit 31 – If set to 1'b1, initialization is over; if set to 1'b0, means initialization in process
4. If the card supports voltage switching, then the software must perform the steps discussed for either the “Voltage Switch Normal Scenario” or the “Voltage Switch Error Scenario”.

Voltage Switch Normal Scenario

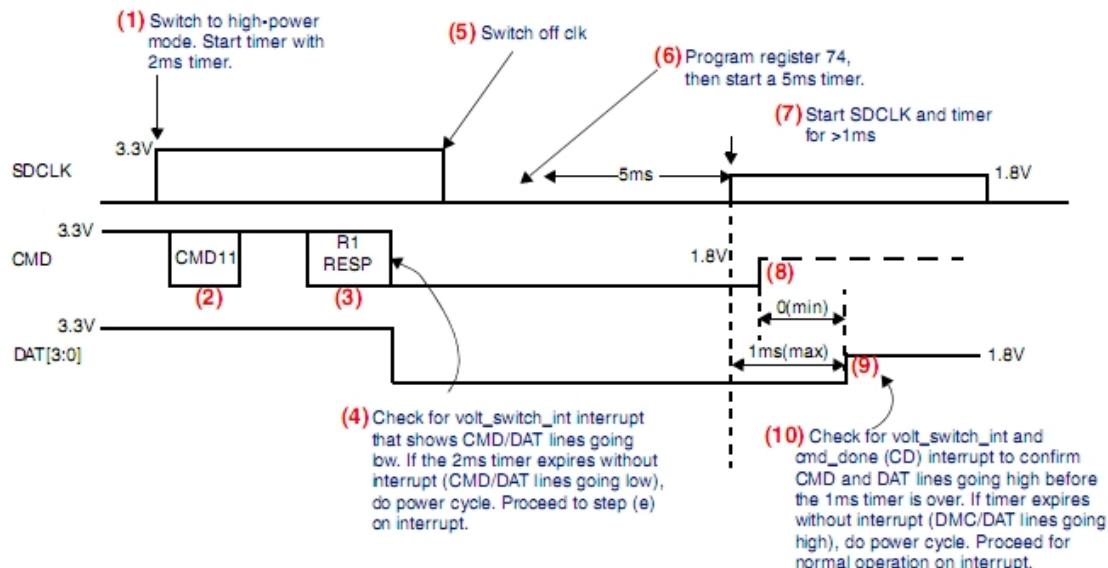


Fig. 17- 17 Voltage Switch Normal Scenario

1. The host programs CLKENA—cclk_low_power register—with zero (0) for the corresponding card, which makes the host controller move to high-power mode. The application should start a timer with a recommended value of 2ms; this value of 2 ms is determined as below:
 Total clk required for CMD11 = 48 clks
 Total clk required for RESP R1 = 48 clks
 Maximum clk delay between MCD11 end to start of RESP1 = 60 clks
 Total = 48+48 + 60 = 160
 Minimum frequency during enumeration is 100KHz; that is, 10us
 Total time = 160 * 10us = 1600us = 1.6ms ~ 2ms
2. The host issues CMD11 to start the voltage switch sequence. Set bit 28 to 1'b1 in CMD when setting CMD11; for more information on setting bits, refer to “Boot Operation”.

3. The card returns R1 response; the host controller does not generate cmd_done interrupt on receiving R1 response.
4. The card drives CMD and DAT [3:0] to low immediately after the response. The host controller generates interrupt (VOLT_SWITCH_INT) once the CMD or DAT [3:0] line goes low. The application should wait for this interrupt. If the 2ms timer expires without an interrupt (CMD/DAT lines going low), do a power cycle.
Note: Before doing a power cycle, switch off the card clock by programming CLKENA register
Proceed to step (5) on getting an interrupt (VOLT_SWITCH_INT).
Note: This interrupt must be cleared once this interrupt is received. Additionally, this interrupt should not be masked during the voltage switch sequence.
If the timer expires without interrupt (CMD/DAT lines going low), perform a power cycle. Proceed to step (5) on interrupt.
5. Program the CLKENA, cclk_enable register, with 0 for the corresponding card; the host stops supplying SDCLK.
6. Program VOLT_REG to the required values for the corresponding card. The application must program the newly-defined VOLT_REG register to assign 1 for the bit corresponding to the card number. The application should start a timer > 5ms.
7. After the 5ms timer expires, the host voltage regulator is stable. Program CLKENA, cclk_enable register, with 1 for the corresponding card; the host starts providing SDCLK at 1.8V; this can be at zero time after VOLT_REG has been programmed. When the CLKENA register is programmed, the application should start another timer > 1ms.
8. By detecting SDCLK, the card drives CMD to high at 1.8V for at least one clock and then stops driving (tri-state); CMD is triggered by the rising edge of SDCLK (SDR timing).
9. If switching to 1.8V signaling is completed successfully, the card drives DAT [3:0] to high at 1.8V for at least one clock and then stops driving (tri-state); DAT [3:0] is triggered by the rising edge of SDCLK (SDR timing). DAT[3:0] must be high within 1ms from the start of SDCLK.
10. The host controller generates a voltage switch interrupt(VOLT_SWITCH_INT) and a command done (CD) interrupt once the CMD and DAT[3:0] lines go high. The application should wait for this interrupt to confirm CMD and DAT lines going high before the 1ms timer is done.
If the timer expires without the voltage switch interrupt (VOLT_SWITCH_INT), a power cycle should be performed. Program the CLKENA register to stop the clock for the corresponding card number. Wait for the cmd_done (CD) interrupt. Proceed for normal operation on interrupt. After the sequence is completed, the host and the card start communication in SDR12 timing.

Voltage Switch Error Scenario

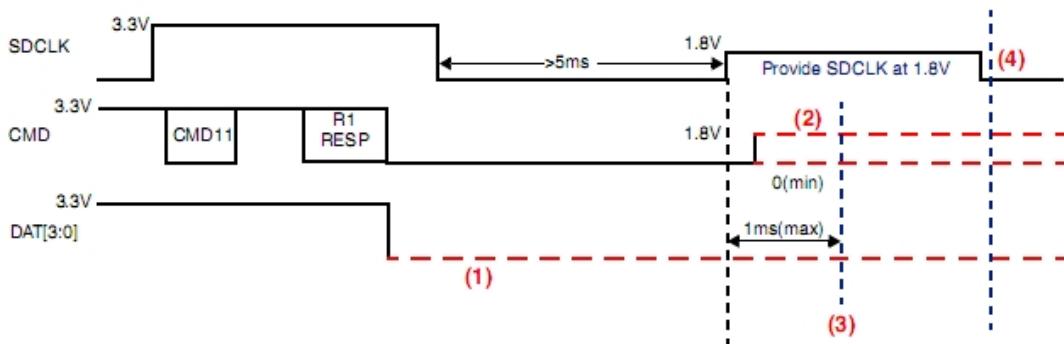


Fig. 17-18 Voltage Switch Error Scenario

1. If the interrupt (VOLT_SWITCH_INT) does not come, then the 2 ms timer should time out and a power cycle should be initiated.
Note: Before performing a power cycle, switch off the card clock by programming CLKENA register; no cmd_done (CD) interrupt is generated.
Additionally, if the card detects a voltage error at any point in between steps (5) and (7) in Figure 17-17, the card keeps driving DAT[3:0] to low until card power off.
2. CMD can be low or tri-state.
3. The host controller generates a voltage switch interrupt once the CMD and DAT[3:0] lines go high. The application should check for an interrupt to confirm CMD and DAT lines going high before the 1 ms timer is done. If the 1 ms timer expires without interrupt (VOLT_SWITCH_INT) and cmd_done (CD), a power cycle should be performed. Program the CLKENA register to stop SDCLK of the corresponding card. Wait for the cmd_done interrupt. Proceed for normal operation on interrupt.
4. If DAT[3:0] is low, the host drives SDCLK to low and then stops supplying the card power.

Note: The card checks voltages of its own regulator output and host signals to ensure they are less than 2.5V. Errors are indicated by (1) and (2) in Figure 7-18.

- If voltage switching is accepted by the card, the default speed is SDR12.
- Command Done is given:
 - If voltage switching is properly done, CMD and DAT line goes high.
 - If switching is not complete, the 1ms timer expires, and the card clk is switched off.

Note: No other CMD should be driven before the voltage switching operation is completed and Command Done is received.

- The application should use CMD6 to check and select the particular function; the function appropriate-speed should be selected. After the function switches, the application should program the correct value in the CLKDIV register, depending on the function chosen. Additionally, if Function 0x4 of the Access mode is chosen—that is, DDR50, then the application should also program 1'b1 in DDR_REG for the card number that has been selected for DDR50 mode.

DDR Operation

DDR programming should be done only after the voltage switch operation has completed. The following outlines the steps for the DDR programming sequence:

1. Once the voltage switch operation is complete, the user must program VOLT_REG to the required values for the corresponding card.
- To start a card to work in DDR mode, the application must program a bit

- of the newly defined VOLT_REG[31:16] register with a value of 1'b1.
- The bit that the user programs depends on which card is to be accessed in DDR mode.
2. To move back to SDR mode, a power cycle should be run on the card—putting the card in SDR12 mode—and only then should VOLT_REG[31:16] be set back to 1'b0 for the appropriate card.

Reset Command/Moving from DDR50 to SDR12

To reset the mode of operation from DDR50 to SDR12, the following sequence of operations has to be done by the application:

1. Issue CMD0.
- When CMD0 is received, the card changes from DDR50 to SDR12.
2. Program the CLKDIV register with an appropriate value.
3. Set DDR_REG to 0.

Note: The VOLT_REG register should not be programmed to 0 while switching from DDR50 to SDR12, since the card is still operating in 1.8V mode after receiving CMD0.

17.7.5 H/W Reset Operation

When the RST_n signal goes low, the card enters a pre-idle state from any state other than the inactive state.

H/W Reset Programming Sequence

The following outlines the steps for the H/W reset programming sequence:

1. Program CMD12 to end any transfer in process.
2. Wait for DTO, even if no response is sent back by the card.
3. Set the following resets:
 - DMA reset– CTRL[2]
 - FIFO reset – CTRL[1] bits

Note: The above steps are required only if a transfer is in process.

4. Program the CARD_RESET register with a value of 0; this can be done at any time when the card is connected to the controller. This programming asserts the RST_n signal and resets the card.
5. Wait for minimum of 1 μ s or cclk_in period, whichever is greater
6. After a minimum of 1 μ s, the application should program a value of 0 into the CARD_RESET register. This de-asserts the RST_n signal and takes the card out of reset.
7. The application can program a new CMD only after a minimum of 200 μ s after the de-assertion of the RST_n signal, as per the MMC 4.41 standard.

Note: For backward compatibility, the RST_n signal is temporarily disabled in the card by default. The host may need to set the signal as either permanently enabled or permanently disabled before it uses the card.

Chapter 18 Embedded SRAM

18.1 Overview

The Embedded SRAM is the AXI slave device, which support read and write access to provide system fast access data storage.

18.1.1 Features supported

- Provide 16KB access space
- Support security and non-security access
- Security or non-security space is software programmable
- Security space is 0KB,4KB,8KB,12K ,16K(the whole memory space)
- Support 64bit AXI bus

18.1.2 Features not supported

- Don't support AXI lock transaction
- Don't support AXI exclusive transaction
- Don't support AXI cache function
- Don't support AXI protection function

18.2 Block Diagram

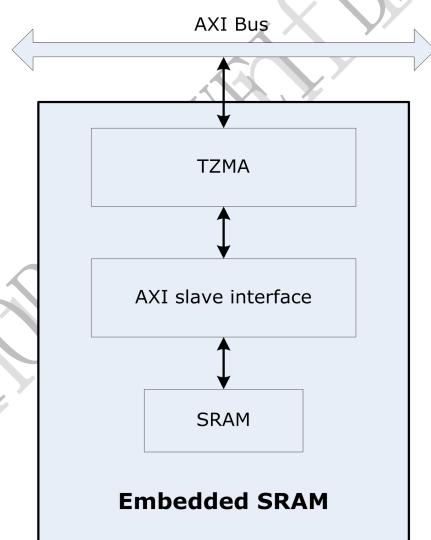


Fig. 18-1 Embedded SRAM block diagram

18.3 Function Description

18.3.1 TZMA

Please refer to 5.3.3 for TZMA functional description.

18.3.2 AXI slave interface

The AXI slave interface is bridge which translate AXI bus access to SRAM interface.

18.3.3 Embedded SRAM access path

The Embedded SRAM can only be accessed by Cortex-A9 and DMAC0.

Chapter 19 GPU (Graphics Process Unit)

19.1 Overview

The GPU is designed for feature phone/Set Top Box/PDA/handheld gaming applications. Its triangle rate can be 33.3 Mtris/s , pixel rate can be 800Mpix/s.

The GPU efficiently processes a number of differing multimedia data types concurrently:

- Pixel Data
- Vertex Data
- Video Data
- General Purpose Processing (e.g. image processing)

19.1.1 GPU Architecture - Key Features

- 3D graphics, vector graphics and video encode and decode supported on common hardware
- Tile based architecture
- Universal Scalable Shader Engine – multi-threaded engine incorporating Pixel and Vertex Shader functionality
- Advanced Shader Feature Set – in excess of Microsoft VS3.0, PS3.0 & OGL2.0
- Industry standard API support – Direct3D Mobile, OGL-ES 1.1 and 2.0, OpenVG 1.1, OpenMax
- Fine grained task switching, load balancing and power management
- Advanced geometry DMA driven operation for minimum CPU interaction
- Programmable high quality image anti-aliasing
- Fully virtualised memory addressing for OS operation in a unified memory architecture
- Standard master and slave AXI bus interfaces.

19.1.2 2D Features

- Basic 2D Features
 - ROP2, 3 & 4 support (including AA text)
 - Source, Pattern (brush), Destination & Mask surface support.
 - Alpha Blending (per-pixel and global)

The programmable nature of POWERVR SGX also enables advanced 2D graphics processing beyond the traditional desktop drawing of BLTs and ROPs. For many application areas vector graphic APIs such as OpenVG are used to create high quality UIs for mobile phones, car navigation systems, set-top boxes and more.

- Advanced 2D Features
 - Geometry generation
 - Translucency
 - Gradients
 - Complex Pixel Filters
 - High Order Anti-aliasing
 - Perspective texturing
 - Transformations
 - Strokes
 - Smooth arbitrary rotation

19.1.3 3D Features

- Deferred Pixel Shading
- 32bit floating point depth accuracy with on chip depth buffer
- 8-bit Stencil with on chip tile stencil buffer
- 8 parallel depth/stencil tests per clock
- Scissor test
- Texture support
 - Cube Map
 - Projected Textures
 - Non square Textures
- Texture Formats
 - RGBA 8888, 565, 1555, 1565
 - Mono chromatic 8, 16, 16f, 32f, 32int
 - Dual channel, 8:8, 16:16, 16f:16f
 - Compressed Textures PVR-TC1, PVR-TC2, ETC1
 - Programmable support for YUV formats
- Resolution Support
 - Frame buffer max size = 2048 x 2048
 - Texture max size = 2048 x 2048
- Texture Filtering
 - Bilinear, Trilinear, Anisotropic
 - Independent min and mag control
- Anti-aliasing
 - 4x Multisampling
 - up to 16x Full scene anti-aliasing
 - Programmable sample positions
- Indexed Primitive List support
- Bus mastered
- Programmable vertex DMA
- Render to texture
 - Including twiddled formats
 - Auto MipMap generation
- Multiple on chip render targets (MRT) – dependent on availability of on chip SoC memory used as intermediate data stores not included in the GPU.

For detailed information about **GPU**, please refer to **RK3168 GPU.pdf**.

Chapter 20 VCODEC (Video encoder and decoder Unit)

20.1 Overview

VCODEC is composed of video decoder and video encoder. VCODEC is connected to VCODEC_AHB bus through an AHB slave and VCODEC_AXI through an AXI master. The register setting is configured through the AHB slave interface and the stream data is read and written through the AXI master interface.

Video decoder and video encoder share many internal memories and they also share the bus master and slave interfaces. So it prevents video decoder and video encoder from working simultaneously. Encoding and decoding now have to time-share the memory resource on a frame by frame basis.

For detailed information about **VCODEC**, please refer to **RK3168
VCODEC.pdf**.

Chapter 21 IPP (Image Post Processor)

21.1 Overview

Image Post Processing (IPP) is used doing image scaler, deinterlace and rotation. Each processing can be done independently or combined with others.

21.1.1 Features

◆ **Input data format**

- RGB888: 16x16 to 8191x8191
- RGB565:16x16 to 8191x8191
- YUV422/YUV420: 16x16 to 8190x8190
- YUV444:16x16 to 8190x8190

◆ **Pre Scaler**

- Down-scaling
- Integral scaling ratio, from 1/8 to 1/2
- Linear filter
- Deinterlace

◆ **Post Scaler**

- Down-scaling and up-scaling
- Arbitrary non-integer scaling ratio, from 1/2 to 4
- 4-tap vertical, 2-tap horizontal filter
- The max output image width of post scaler is 4096

◆ **Rotation**

- 90-degree, 180-degree, 270-degree rotation
- x-mirror, y-mirror

For detailed information about **IPP**, please refer to **RK3168 IPP.pdf**.

Chapter 22 LCDC

22.1 Overview

LCD Controller is the display interface from memory frame buffer to display device(LCD panel or TV set). LCDC is connected to LCDC_AHB bus through an AHB slave and DISP_AXI bus through an AXI master. The register setting is configured through the AHB slave interface and the display frame data is read through the AXI master interface.

There are two symmetrical LCDCs in SOC for dual panel display application.

22.1.1 Features

◆ Display interface

- Parallel RGB LCD Interface: 24-bit(RGB888), 18-bit(RGB666), 15-bit(RGB565)
- Serial RGB LCD Interface: 3x8-bit(RGB delta support), 3x8-bit + dummy, 16-bit + 8-bit
- MCU LCD interface: i-8080(up to 24-bit RGB), Hold/Auto/Bypass modes
- TV Interface: ITU-R BT.656(8-bit, 480i/576i/1080i)

◆ Display process

- Background layer: programmable 24-bit color
- Win0 layer:
 - ARGB888, RGB565, YCbCr422, YCbCr420, YCbCr444
 - Maximum resolution is 1920x1080, support virtual display
 - 1/8 to 8 scaling-down and scaling-up engine
 - 256 level alpha blending
 - Transparency color key
 - De-flicker support for interlace output
- Win1 layer:
 - ARGB888, RGB565
 - Maximum resolution is 1920x1080,support virtual display
 - 256 level alpha blending
 - Transparency color key
- Win2 layer:
 - 1/2/4/8bpp palette
 - Maximum resolution is 1920x1080
 - 256 level alpha blending
 - Transparency color key
- Hardware cursor:
 - 2bpp
 - 32x32 size
 - 3-color and transparentmode
 - 2-color + transparency + tran_invert mode
 - 16 level alpha blending

◆ Others

- 3 x 256 x 8 bits display LUTs
- Win0 layer and Win1 layer overlay exchangeable
- YCbCr2RGB(rec601-mpeg/ rec601-jpeg/rec709) and RGB2YCbCr modules
- Replication(16-bit to 24-bit) and Dithering(24-bit to 16-bit/18-bit)
- Blank and black display
- Standby mode

22.2 Block Diagram

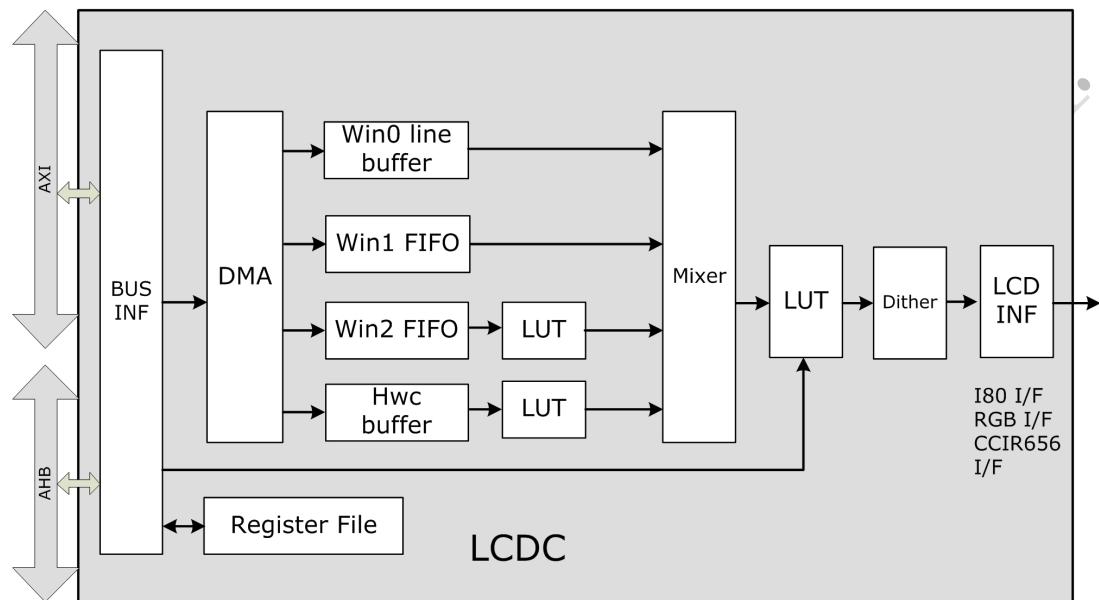


Fig. 22-1 LCDC Block Diagram

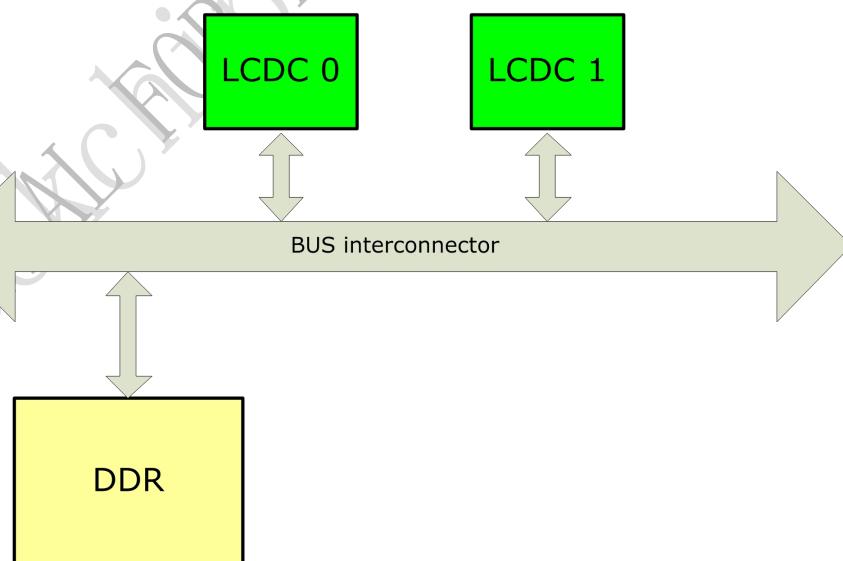


Fig. 22-2 LCDC Dual LCDCs in SOC

22.3 Function Description

22.3.1 Data Format

LCD master read the frame data from the frame buffer in the system memory (SDR or DDR). There are total 9 formats supported in three layers.

- Win0: ARGB888, RGB565, YCbCr422, YCbCr420, YCbCr444
- Win1: ARGB888, RGB565
- Win2: 1bpp, 2bpp, 4bpp, 8bpp
- Hwc: 2bpp

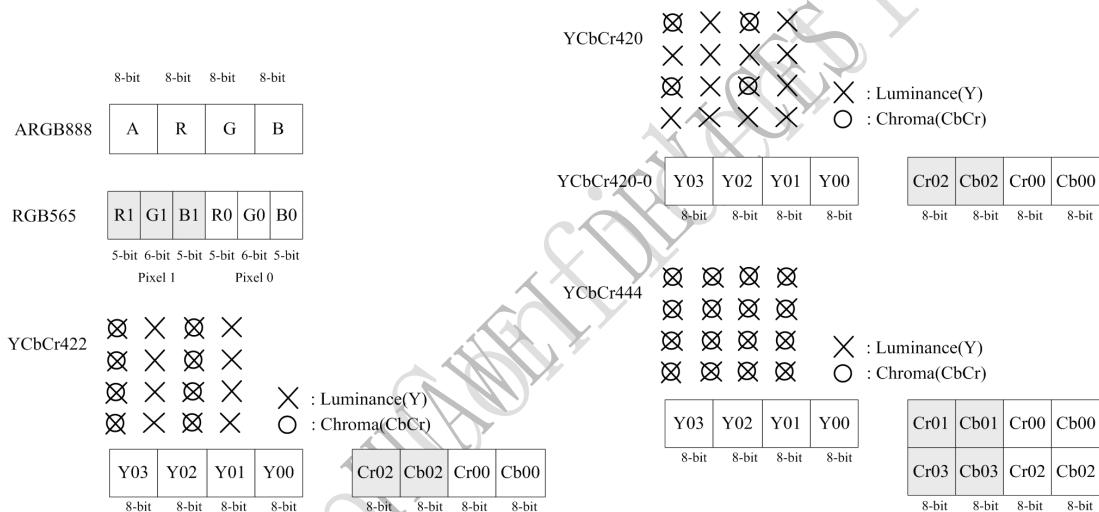


Fig. 22-3 LCD Frame Buffer Data Format

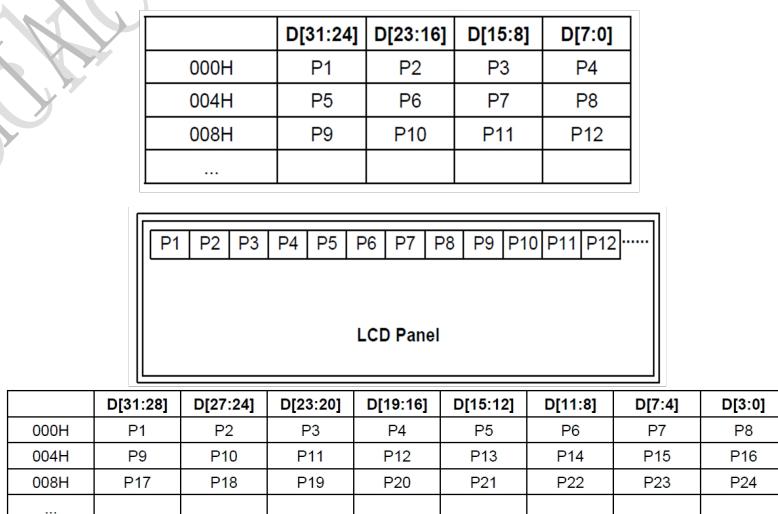


Fig. 22-4 LCDC Win2 Palette (8bpp/4bpp)

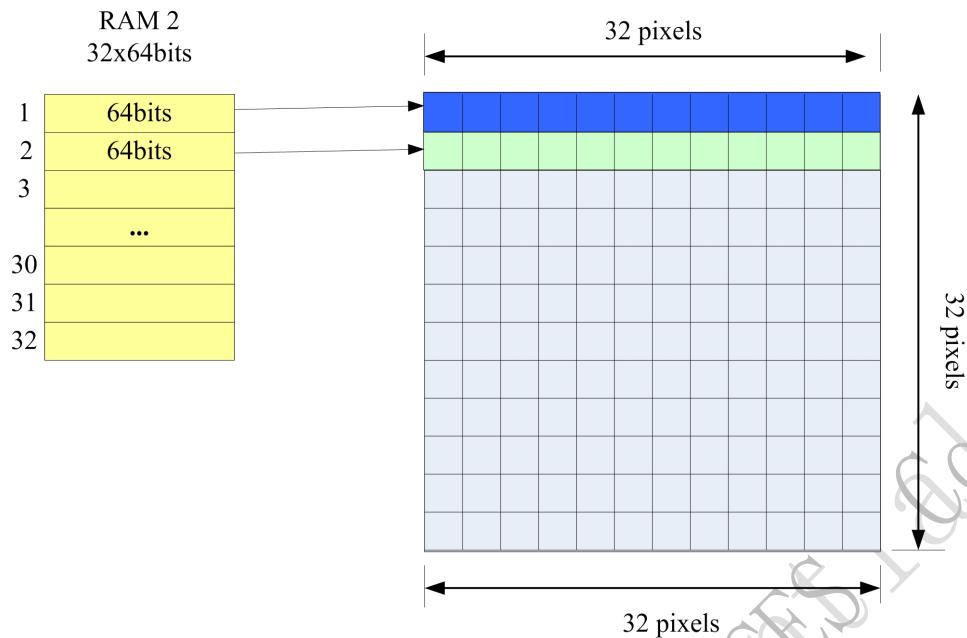


Fig. 22-5LCD C Hwc Data Format

Table 22-1Hwc 3-color Transparency Mode

Data[1:0]	Display Pixel color
00	Cusor color 0
01	Cusor color 1
10	Cusor color 2
11	Transparent

Table 22-2Hwc 2-color Transparency Mode

Data[1:0]	Display Pixel color
00	Cusor color 0
01	Cusor color 1
10	Transparent
11	Inverted-Transparent

Data SWAP function

There are several data-swap modes for flexible application. The register is LCDC_SWAP_CTRL[11:0] and LCDC_SWAP_CTRL[17].

For RGB data, there are 6 types of data-swap for WIN0 and 5 types for WIN1, Big-endian/Little-endian can be set for win2 8bpp palette data.

Table 22-3LCD C RGB/Y Data swap of WIN0, WIN1 and WIN2

Data-swap (RGB/Y)	<i>8bit swap</i>	<i>16bit swap</i>	<i>middle swap</i>	<i>right-shift swap</i>	<i>RB swap</i>	Big-endian/Little-endian
WIN0	yes	yes	yes	yes	yes	No
WIN1	yes	yes	yes	yes	yes	No
WIN2	No	No	No	No	No	yes

Table 22-4LCDC CbCr Data swap of WIN0

Data-swap (CbCr)	<i>8bit swap</i>	<i>16bit swap</i>	<i>right-shift 8-bit swap</i>
WIN0	yes	yes	yes

22.3.2 Virtual display

Virtual display is supported in WIN0 and WIN1. The active frame is part of the virtual (original) frame in frame buffer memory. First, Vir_width/Vir_height and the memory start of virtual (Vir_mst) frame must be set to LCDC_WIN0_VIR/LCDC_WIN1_VIR, LCDC_WIN0_YRGB_VIR_MST/LCDC_WIN0_CBR_VIR_MST/LCDC_WIN1_VIR_MST.

The display frame on the panel is the active frame, whose Act_width/Act_height and Act_mst is indicated in LCDC_WIN0_ACT_INFO/LCDC_WIN1_ACT_INFO, LCDC_WIN0_YRGB_ACT_MST/LCDC_WIN0_CBR_ACT_MST/LCDC_WIN1_ACT_MST.

The register setting of Vir_width/Vir_height and Act_width/Act_height should be multiples of 2 when the data formats RGB565 or YCbCr420, It should be multiples of 4 when the data format is YCbCr422, YCbCr420 or YCbCr444.

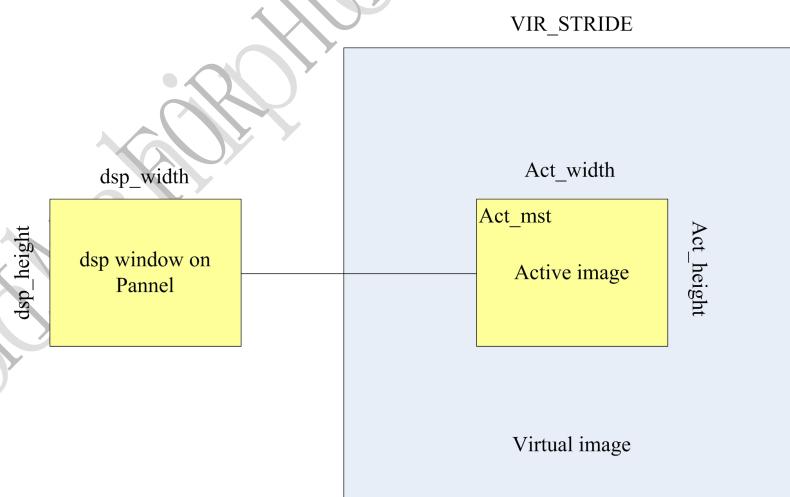


Fig. 22-6LCDC Virtual Display Mode

22.3.3 Scaling

The scaling operation is the imageresizing processof data transfer from the frame buffer memory toLCD panel or TV set. There are two scaling units: Scaling down and scaling up.

If the display frame's width or height is smaller than the active frame's width or height. Scaling down operation is done by setting the scaling down factor (vertical/horizontal). Similarly, If the display frame's width or height is great than the active frame's width or height. Scaling up operation is done by setting the scaling up factor (vertical/horizontal).

The virtual scaling and horizontal scaling, scaling down and scaling up units are independent, so neither of them, only one, or both can be used simultaneously.

1. Scaling factor

Because the chroma data may have different sampling rate with Luma data in the memory format of YCbCr422/YCbCr420. The scaling factor of Win0 has two couples of factor registers:

LCDC_WIN0_SCL_FACTOR_Y/LCDC_WIN0_SCL_FACTOR_CBR

Software calculates the scaling factor value using the following equations:

$$y_rgb_vertical_factor = \left(\frac{LCDC_WIN0_ACT_INFO[31:16]}{LCDC_WIN0_DSP_INFO[31:16]} \right) \times 2^{12}$$

$$y_rgb_horizontal_factor = \left(\frac{LCDC_WIN0_ACT_INFO[15:0]}{LCDC_WIN0_DSP_INFO[15:0]} \right) \times 2^{12}$$

$$yuv422_yuv444_Cbr_vertical_factor = \left(\frac{LCDC_WIN0_ACT_INFO[31:16]}{LCDC_WIN0_DSP_INFO[31:16]} \right) \times 2^{12}$$

$$yuv420_Cbr_vertical_factor = \left(\frac{LCDC_WIN0_ACT_INFO[31:16]/2}{LCDC_WIN0_DSP_INFO[31:16]} \right) \times 2^{12}$$

$$yuv444_Cbr_horizontal_factor = \left(\frac{LCDC_WIN0_ACT_INFO[15:0]}{LCDC_WIN0_DSP_INFO[15:0]} \right) \times 2^{12}$$

$$yuv422_yuv420_Cbr_horizontal_factor = \left(\frac{LCDC_WIN0_ACT_INFO[15:0]/2}{LCDC_WIN0_DSP_INFO[15:0]} \right) \times 2^{12}$$

2. Scaling start point offset

The x and y start point of the generated pixels can be adjusted, the offset value is in the range of 0 to 0.99.

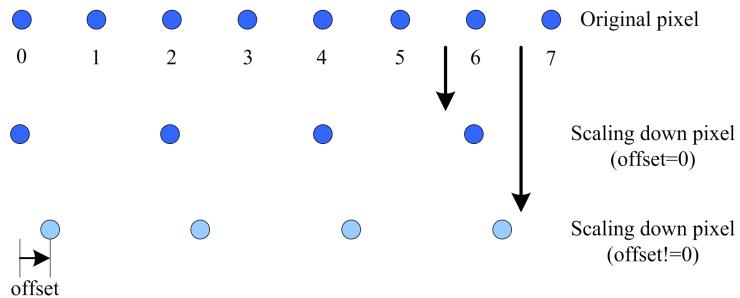


Fig. 22-7LCD Scaling Down Offset

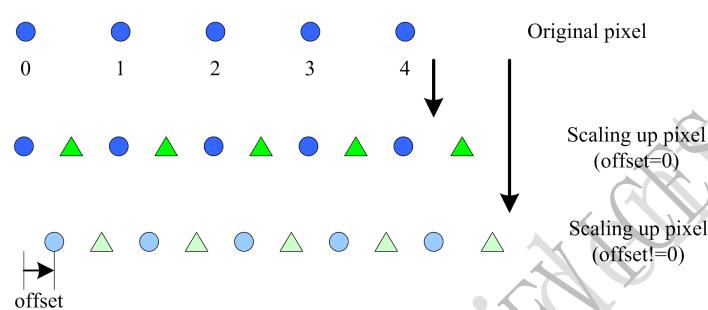


Fig. 22-8LCD Scaling Up Offset

Table 22-5LCD Scaling Start Point Offset Registers

scaling down/up start point offset	Offset variable	Register
Win0 YRGB vertical scaling offset	Win0_YRGB_vscl_offset	Win0_SCL_OFFSET [32:24]
Win0 YRGB horizontal scaling offset	Win0_YRGB_hscl_offset	Win0_SCL_OFFSET [23:16]
Win0 Cbr vertical scaling offset	Win0_CBR_vscl_offset	Win0_SCL_OFFSET [15:8]
Win0 Cbr horizontal scaling offset	Win0_CBR_hscl_offset	Win0_SCL_OFFSET [7:0]

3. De-flicker (Interlace vertical filtering)

It is necessary to display a non-interlaced video signal on an interlaced display (such as TV set). Thus some form of "non-interlaced-to-interlaced conversion" may be required.

The easiest approach is to throw away every other active scan line in each non-interlaced frame. Although the cost is minimal, there are problems with this approach. If there is a sharp vertical transition of color or intensity. It will flicker

at one-half the refresh rate.

A better solution is to use two lines of non-interlaced data to generate one line of interlace data. Fast vertical transitions are smoothed out over several interlace lines.

The vertical filtering of two non-interlaced lines can be done by enabling the vertical scaling offset dynamic change in different field (even/odd). The dynamic change value of scaling offset is half of the scaling factor. You should enable the scaling down vertical offset in scaling down mode; enable the scaling up vertical offset in scaling up mode, or one of it in no-scaling mode.

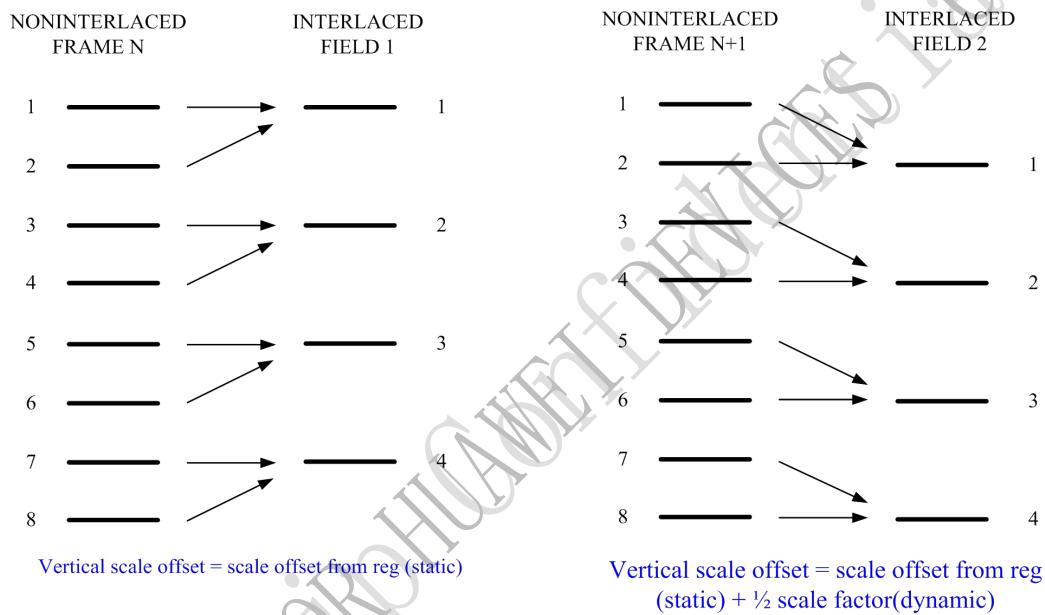


Fig. 22-9LCD Interlace Vertical Filtering

22.3.4 Overlay

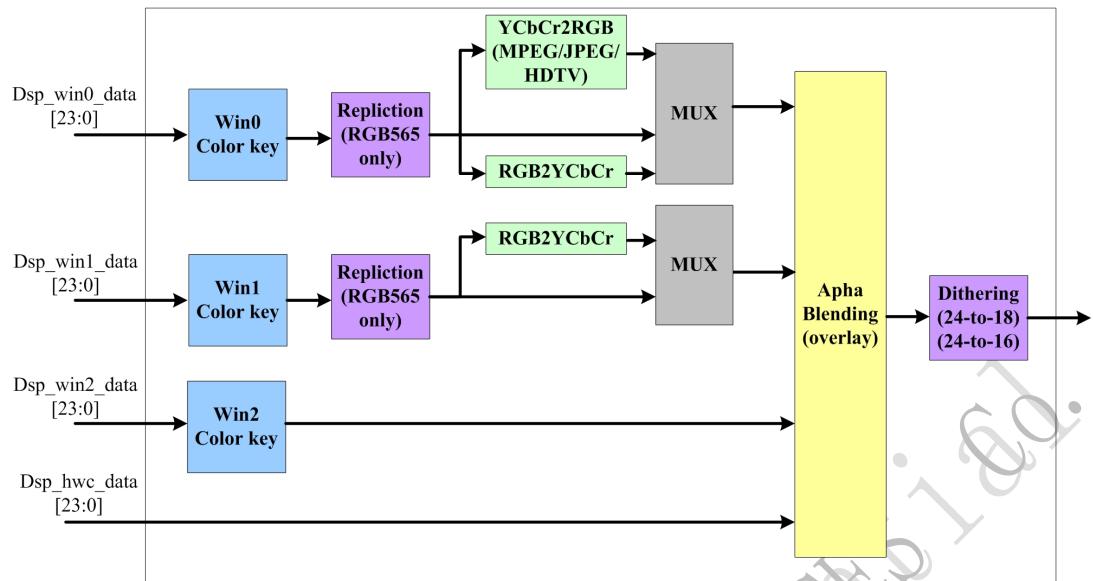


Fig. 22-10 LCDC Overlay Block Diagram

1. Overlay display

There are totally 5 layers for overlay display: Background, Win0, Win1, Win2 and Hwc.

The background is a programmable solid color layer, which is always the bottom of the display screen.

Hwc is a 32x32 3-LUT-colors layer, which is on the top layer of the display screen.

The two middle layers are WIN0 and WIN1. WIN1 is on the top of WIN0 in default setting, setting LCDC_BLEND_CTRL[5] to '1' can let WIN0 be on the top of WIN1.

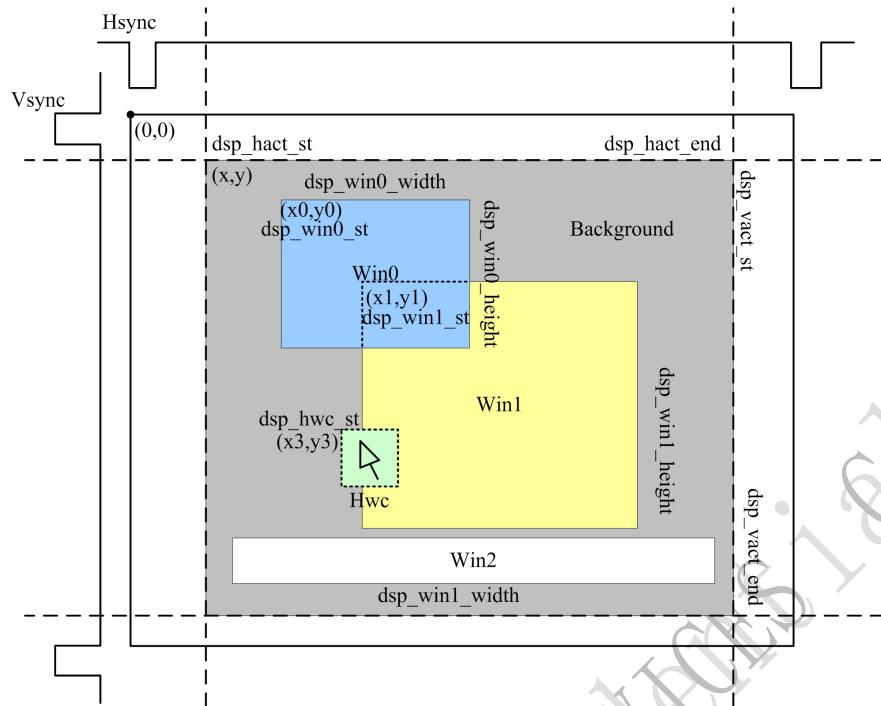


Fig. 22-11 LCD Overlay Display

2. Transparency color key

There are three transparency color keys **Win0/Win1/Win2** layer. The two transparency color key can be active at the same time.

The pixel color value is compared to the transparency color key before final display. The transparency color key value defines the pixel data considered as the transparent pixel. The pixel values with the source color key value are pixels not visible on the screen, and the under layer pixel values or solid background color are visible.

Transparency color key is done after the scaling module and before the YCbCr2RGB color space converter. So transparency color key can only be used in non-scaling mode.

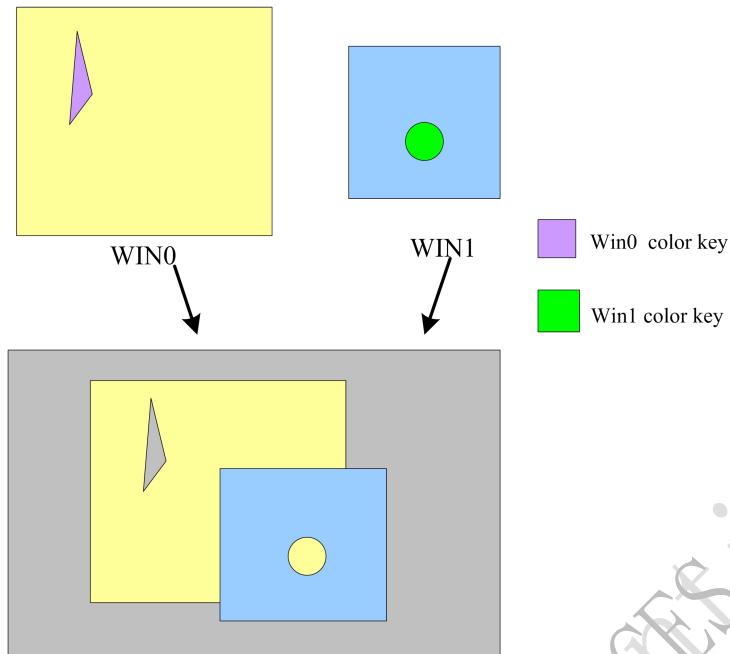


Fig. 22-12LCD Transparency Color Key

3. Alpha Blending

There are 3 alpha for blending between the 4 overlay layers:
`alpha_win0[7:0]`, `alpha_win1[7:0]`, `alpha_hwc[3:0]`.

There are two blending mode. One is per-pixel (ARGB) mode, the other is user-specified mode. In ARGB mode, the alpha value is in the ARGB data (WIN0 and WIN1 normal mode only). In user-specified mode, the alpha value comes from the register (LCDC_BLEND_CTRL[31:24], LCDC_BLEND_CTRL[23:16], LCDC_BLEND_CTRL[15:12]).

ARGB blending mode is enable after writing '1' to `LCDC_BLEND_CTRL[4]` and `LCDC_BLEND_CTRL[5]`.

In HWC layer, if the data of the hwc pixel is 2'b00, then this pixel is transparent (alpha = 0), regardless the alpha setting of alpha value.

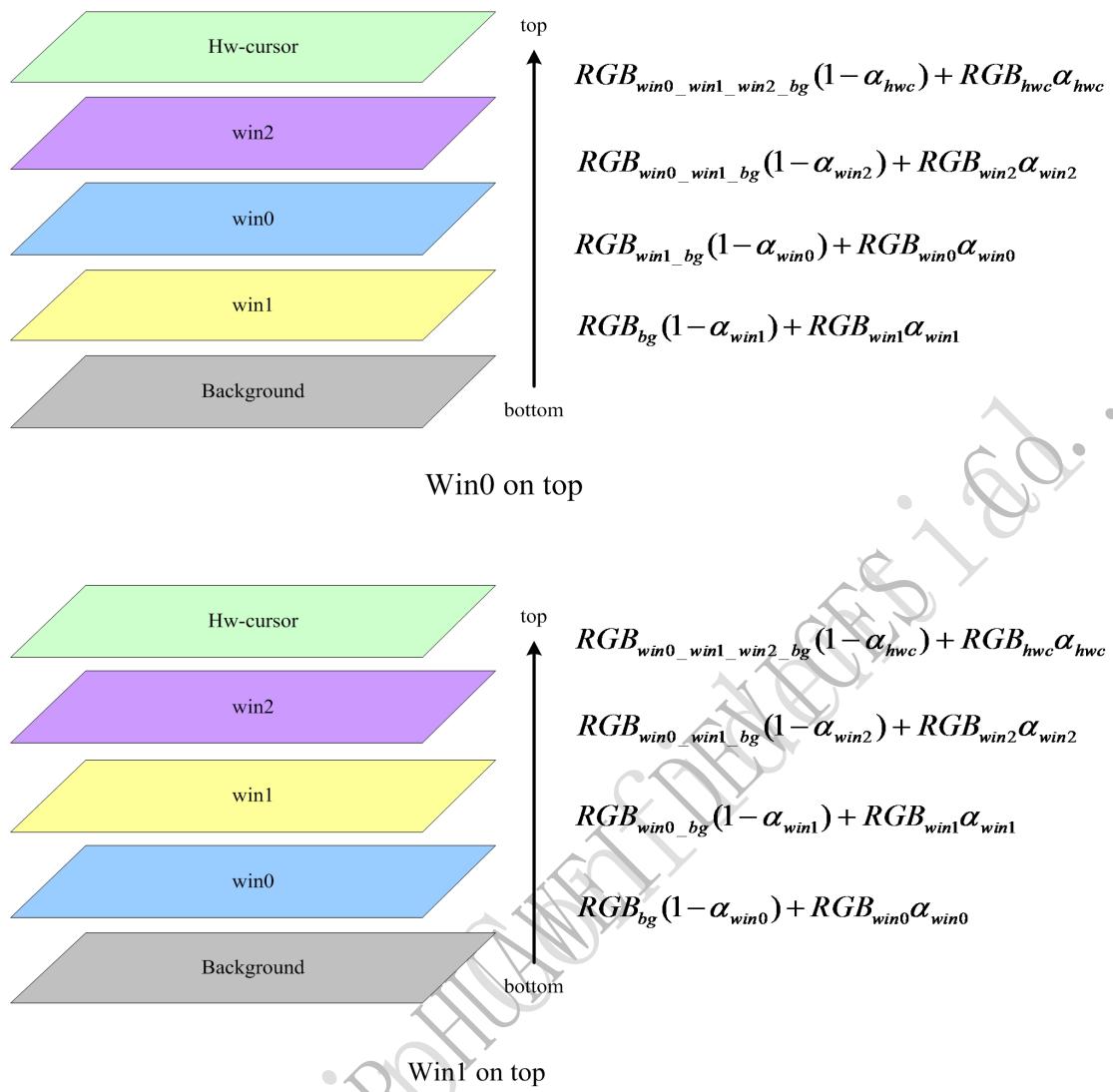


Fig. 22-13LCD Alpha blending

4. Replication and Dithering

If the interface data bus is wider than the pixelformat size, by programming the pixel components replication active/inactive, the MSB is replicated to the LSB of the interface data bus or the LSB is filled with 0s.

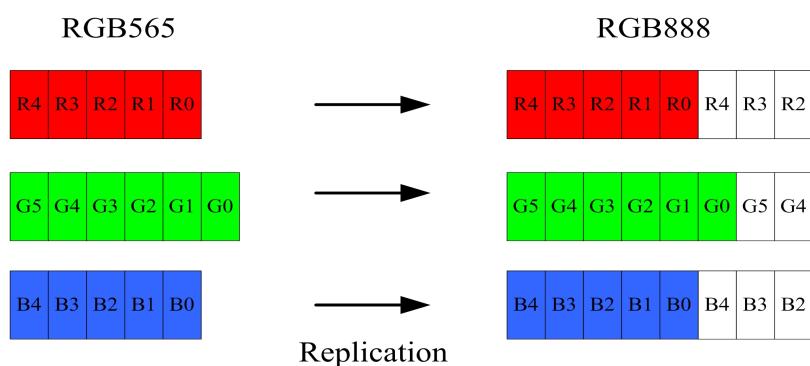


Fig. 22-14LCD Replicaiton

Dithering is an intentionally applied form of noise, used to randomize quantization error, thereby preventing large-scaling patterns such as "banding".

The pixel values are used by Dithering logic to display the data in a lower color depth on the LCD panel. The Dithering algorithm is based on the (x,y) pixel position and the value of removed bits. The picture quality is improved when enabling the Dithering logic. When Dithering is not enabled, the MSBs of the pixel color components are output on the interface data bus if the interface data bus is smaller than the pixel format size.

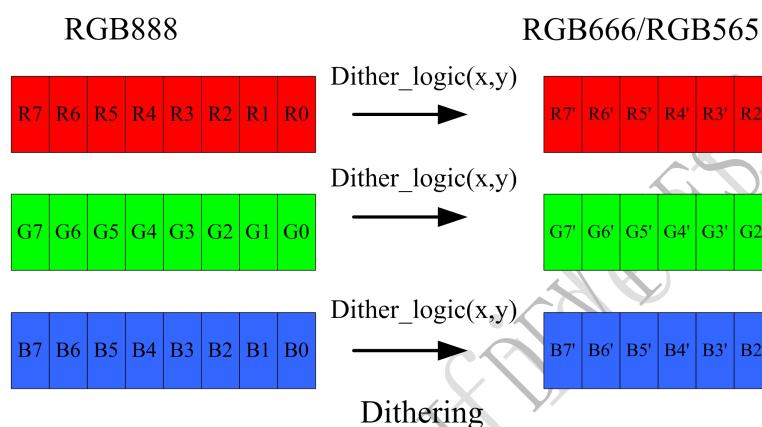


Fig. 22-15LCD C Dithering

22.4 Register Description

22.4.1 Register Summary

Name	Offset	Size	Reset Value	Description
LCDC_SYS_CONFIG	0x00	W	0x0	SYSTEM configure register
LCDC_SWAP_CTRL	0x04	W	0x0	Data SWAP control
LCDC MCU_TIMING_CTRL	0x08	W	0x00100401	MCU TIMING control register
LCDC_BLEND_CTRL	0x0C	W	0x0	Blending control register
LCDC_WIN0_COLOR_KEY_CTRL	0x10	W	0x0	Win0 blending control register
LCDC_WIN1_COLOR_KEY_CTRL	0x14	W	0x0	Win1 blending control register
LCDC_WIN2_VIR	0x18	W	0x0	WIN2 virtual display width
LCDC_DSP_CTRL0	0x1C	W	0x00100000	Display control register0
LCDC_DSP_CTRL1	0x20	W	0x01000000	Display control register1
LCDC_INT_STATUS	0x24	W	0x00000380	Interrupt status register
LCDC_WIN0_VIR	0x28	W	0x0	WIN0 virtual display width
LCDC_WIN0_YRGB_MST	0x2C	W	0x0	Win0 YRGB memory start address
LCDC_WIN0_CBR_MST	0x30	W	0x0	Win0 Cbr memory start address
LCDC_WIN0_ACT_INFO	0x34	W	0x0	Win0 active window

				width/height
LCDC_WIN0_DSP_ST	0x38	W	0x0	Win0 display start point on panel
LCDC_WIN0_DSP_INFO	0x3C	W	0x0	Win0 display width/height on panel
LCDC_WIN1_VIR	0x40	W	0x0	Win1 virtual display width
LCDC_WIN1_MST	0x44	W	0x0	Win1 memory start address
LCDC_WIN1_DSP_INFO	0x48	W	0x0	Win1 display width/height on panel
LCDC_WIN1_DSP_ST	0x4C	W	0x0	Win1 display start point on panel
LCDC_WIN2_MST	0x50	W	0x0	Win2 memory start address
LCDC_WIN2_DSP_INFO	0x54	W	0x0	Win2 display width/height on panel
LCDC_WIN2_DSP_ST	0x58	W	0x0	Win2 display start point on panel
LCDC_HWC_MST	0x5C	W	0x0	HWC memory start address
LCDC_HWC_DSP_ST	0x60	W	0x0	HWC display start point on panel
LCDC_HWC_COLOR_LUT0	0x64	W	0x0	Hardware cursor color 2'b01 look up table 0
LCDC_HWC_COLOR_LUT1	0x68	W	0x0	Hardware cursor color 2'b10 look up table 1
LCDC_HWC_COLOR_LUT2	0x6C	W	0x0	Hardware cursor color 2'b11 look up table 2
LCDC_DSP_HTOTAL_HS_END	0x70	W	0x017F0017	Panel scanning horizontal width and hsync pulse end point
LCDC_DSP_HACT_ST_END	0x74	W	0x02B016A	Panel active horizontal scanning start point and end point
LCDC_DSP_VTOTAL_VS_END	0x78	W	0x01070002	Panel scanning vertical height and vsync pulse end point
LCDC_DSP_VACT_ST_END	0x7C	W	0x000D00FC	Panel active vertical scanning start point and end point
LCDC_DSP_VS_ST_END_F1	0x80	W	0x0	Vertical scanning start point and vsync pulse end point of even field in interlace mode
LCDC_DSP_VACT_ST_END_F1	0x84	W	0x0	Vertical scanning active start point and end point of even field in interlace mode
LCDC_WIN0_SCL_FACTOR_YRGB	0x88	W	0x10001000	Win0 YRGB scaling factor
LCDC_WIN0_SCL_FACTOR_CBR	0x8C	W	0x10001000	Win0 Cbr scaling factor
LCDC_WIN0_SCL_OFFSET	0x90	W	0x0	Win0 scaling start point

				offset
LCDC_FIFO_WATER_MARK	0x94	W	0xe1f0	Fifo water mark.
LCDC_AXI_MS_ID	0x98	W	0x54321	Axi master ID
LCDC_REG_CFG_DONE	0xa0	W	0x0	REGISTER CONFIG FINISH REGISTER.
MCU_BYPASS_WPORT	0x100	W	--	MCU BYPASS MODE, DATA Write Only Port
MCU_BYPASS_RPORT	0x200	W	0x0	MCU BYPASS MODE, DATA Read Only Port
Win2_LUT_ADDR	0x400 ~ 0x7ff	W	--	Access entry for win2 LUT memory(size is word only)
DSP_LUT_ADDR	0x800 ~ 0xbff	W	--	Access entry for DSP LUT memory(size is word only)

Notes:Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

22.4.2 Detail Register Description

LCDC_SYS_CONFIG

Address: Operational Base + offset (0x00)
LCDC system config register

bit	Attr	Reset Value	Description
31	RW	0x0	LCDC layer auto clock gating enable 0: disable 1: enable
30	RW	0x0	Win0 AXI masterread outstanding 2: 0: disable 1: enable
29	RW	0x0	Win1 AXI masterread outstanding 2: 0: disable 1: enable * Win1_FIFO_watermark should be modified according this read mode.
28	RW	0x0	Hwc reversed color mode: 0: normal color mode 1: reversed color mode
27	RW	0x0	Display lut ram control: 0: control by bus; 1: control by lcdc;
26	RW	0x0	Win2 lut ram control: 0: control by bus; 1: control by lcdc;
25:24	RW	0x0	WIN0 AXI Master Burst Control : 2'b00: burst16; 2'b01: burst8; 2'b10: burst4;
23:22	RW	0x0	WIN1 AXI Master Burst Control : 2'b00: burst16; 2'b01: burst8; 2'b10: burst4;
21:20	RW	0x0	WIN2 AXI Master Burst Control : 2'b00: burst16;

			2'b01: burst8; 2'b10: burst4;
19:18	RW	0x0	HWC AXI Master Burst Control : 2'b00: burst16; 2'b01: burst8; 2'b10: burst4;
17	RW	0x0	LCDC stand by mode: Writing "1" to turn LCDC into standby mode, All the layer would disable and the data transfer from frame buffer memory would stop at the end of current frame. The output would be blank. When writing "0" to this bit, standby mode would disable and the LCDC go back to work immediately. 0: disable; 1: enable; <i>* Black display is recommended before setting standby mode enable.</i>
16	RW	0x0	Win0 AHB Master interlace read mode, used in interlace display mode
15	RW	0x0	Win1 AHB Master interlace read mode, used in interlace display mode
14	RW	0x0	Win2 AHB Master interlace read mode, used in interlace display mode
13	RW	0x0	Hardware cursor data reload start bit: hwc refresh at thebeginning of frame. It would be clear after reload finish
12	RW	0x0	hwc enable control 1: enable 0: disable
11	RW	0x0	Win0 enable control 1: enable 0: disable
10	RW	0x0	Win1 enable control 1: enable 0: disable
9	RW	0x0	Win2 enable control 1: enable 0: unenable
8	RW	0x0	Interlace Display Control enable: This mode is related to the ITU-R656 output, the display timing of odd field must be set correctly. (LCDC_DSP_VS_ST_END_F1/LCDC_DSP_VCT_END_F1) 0: disable; 1: enable;
7	RW	0x0	Win0 YRGB deflick enable: 0: unenable; 1: enable;
6	RW	0x0	Win0 Cbr deflick enable: 0: unenable; 1: enable;
5:3	RW	0x0	Win0 Display data Format 3'b000 : RGB888

			3'b001 : RGB565 3'b010 : YCbCr422 3'b011 : YCbCr420 3'b101 : YCbCr444 3'b110 : AYCbCr
2	RW	0x0	Win1 Display data Format: 0: RGB888; 1: RGB565
1:0	RW	0x0	Win2 Display Format: 2'b00: 8bpp; 2'b01: 4bpp; 2'b10: 2bpp; 2'b11: 1bpp;

LCDC_SWAP_CTRL

Address: Operational Base + offset (0x04)

Frame data bit swap register

bit	Attr	Reset Value	Description
31:18	-	-	Reserved
17	RW	0x0	WIN2 8pp palette data Big-endian/Little-endian control 0: Big-endian 1: Little-endian
16	RW	0x0	Dummy swap enable 0: B+G+R+dummy 1: dummy+B+G+R
15	RW	0x0	DISPLAY DELTA SWAP ENABLE See detail in Delta display block.
14	RW	0x0	Display output red and green swap enable 0: RGB 1: GRB
13	RW	0x0	Display output red and blue swap enable 0: RGB 1: BGR
12	RW	0x0	Display output blue and green swap enable 0: RGB 1: RBG
11	RW	0x0	WIN1 8-bit right-shift swap enable 0: ABCD 1: DABC
10	RW	0x0	WIN1 8bit swap enable 0: ABCD 1: BADC
9	RW	0x0	WIN1 16bit swap enable 0: ABCD 1: CDAB
8	RW	0x0	WIN0 Cbr 8bit swap enable 0: ABCD 1: BADC
7	RW	0x0	WIN0 Cbr 16bit swap enable 0: ABCD 1: CDAB
6	RW	0x0	WIN0 YRGB 8bit swap enable 0: ABCD

			1: BADC
5	RW	0x0	WIN0 YRGB 16bit swap enable 0: ABCD 1: CDAB
4	RW	0x0	WIN0 Cbr 8-bit right-shift swap enable 0: ABCD 1: DABC
3	RW	0x0	WIN0 YRGB 8-bit right-shift swap enable 0: ABCD 1: DABC
2	RW	0x0	WIN0 YRGB middle 8-bit swap enable 0: ABCD 1: ACBD
1	RW	0x0	WIN0 RGB565,Red and blue swap enable 0: R1G1B1R0G0B0 1: B1G1R1B0G0R0
0	RW	0x0	WIN1 RGB565,Red and Blue swap enable 0: R1G1B1R0G0B0 1: B1G1R1B0G0R0

LCDC MCU TIMING CTRL

Address: Operational Base + offset (0x08)

MCU LCD interface control register

bit	Attr	Reset Value	Description
31	RW	0x0	MCU LCD output SELECT
30	RW	0x0	MCU LCD BYPASS MODE Select
29	RW	0x0	MCU LCD RS Select
28	RW	0x0	Write "1" :MCU HOLD Mode Frame Start Read: MCU HOLD status
27	RW	0x0	MCU HOLD Mode Select
25	RW	0x0	MCU_CLK_SEL for MCU bypass 1: MCU BYPASS sync with DCLK 0: MCU BYPASS sync with HCLK
24:20	RW	0x1	MCU_RW signal end point
19:15	RW	0x0	MCU_RW signal start point
14:10	RW	0x1	MCU_CS signal end point
9:5	RW	0x0	MCU_CS signal start point
4:0	RW	0x1	MCU LCD Interface writing period

LCDC_BLEND_CTRL

Address: Operational Base + offset (0x0C)

LCDC alpha blending control register

bit	Attr	Reset Value	Description
31:24	RW	0x0	WIN0 alpha blending factor
23:16	RW	0x0	WIN1 alpha blending factor
15:8	RW	0x0	WIN2alpha blending factor
7:4	RW	0x0	HWC alpha blending factor
3	RW	0x0	WIN0 alpha blending enable: 0: disable; 1: enable;
2	RW	0x0	WIN1 alpha blending enable: 0: disable;

			1: enable; WIN2alpha blending enable: 0: disable; 1: enable;
1	RW	0x0	WIN2alpha blending enable: 0: disable; 1: enable;
0	RW	0x0	HWCalpha blending enable: 0: disable; 1: enable;

LCDC_WIN0_COLOR_KEY_CTRL

Address: Operational Base + offset (0x10)

LCDC win0 color key control register

bit	Attr	Reset Value	Description
31:25	RW	0x0	reserved
24	RW	0x0	Win0transparency color key enable: 0: disable; 1: enable;
23:16	RW	0x0	Win0 key color red[7:0];
15:8	RW	0x0	Win0 key color green[7:0];
7:0	RW	0x0	Win0 key color blue[7:0];

LCDC_WIN1_COLOR_KEY_CTRL

Address: Operational Base + offset (0x14)

LCDC win1 color key control register

bit	Attr	Reset Value	Description
31:25	RW	0x0	reserved
24	RW	0x0	Win1transparency color key enable: 0: disable; 1: enable;
23:16	RW	0x0	Win1 key color red[7:0];
15:8	RW	0x0	Win1 key color green[7:0];
7:0	RW	0x0	Win1 key color blue[7:0];

LCDC_WIN2_VIR

Address: Operational Base + offset (0x18)

LCDC win2 virtual width/height registers for Virtual display

bit	Attr	Reset Value	Description
31:16	-	-	Reserved.
15:0	RW	0x0	Win2 Virtual Display Width

LCDC_DSP_CTRL_REG0

Address: Operational Base + offset (0x1C)

LCDC display control register 0

bit	Attr	Reset Value	Description
31:23	-	-	reserved
22	RW	0x0	Win2 not-aligned store mode: 0: not-clip mode; 1: clip mode;
21	RW	0x0	Cb Cr filter in CCIR656 mode: 0: drop mode; 1: average mode;
20	RW	0x1	Win0 Y and Cbr priority mode select: 0: priority mode; 1: no priority mode;

19	RW	0x0	Win0 not-aligned store mode: 0: not-clip mode; 1:clip mode;
18	RW	0x0	Win1 not-aligned store mode: 0: not-clip mode; 1:clip mode;
17	RW	0x0	Win0 or Win1 on the top: 0: win1 on the top; 1: win0 on the top;
16	RW	0x0	WIN0 Transparent factor from register enable: 0:alpha from register; 1: each pixel with a alpha from ARGB;
15	RW	0x0	WIN1 Transparent factor from register enable: 0:alpha from register; 1: each pixel with a alpha from ARGB;
14	RW	0x00	YUV clip 0: disable, YCbCr no clip 1:enable, YCbCr clip before YCbCr2RGB *Y clip: 16~235, CBCR clip: 16~239
13	RW	0x00	Interlace field polarity
12	RW	0x00	Dither_down enable: 0: unenable; 1: enable;
11	RW	0x00	Dither_down_mode 0: RGB888 to RGB565 1: RGB888 to RGB666
10	RW	0x00	dither up RGB565 to RGB888 enable: 0: unenable; 1: enable;
9:8	RW	0x00	Color space conversion: 2'b00: YCbCr2RGB mpeg(ITU601) 2'b01: YCbCr2RGB jpeg(ITU601) 2'b10: YCbCr2RGB hdtv(REC709) 2'b11: YCbCr BYPASS *YCbCr bypass mode is used for ITU-656 output. If the pixel data of win0/win1 is RGB format, RGB2YCbCr conversion is active.
7	RW	0x0	DSP OUTPUT PIN dclk polarity invert 0: normal; 1: invert;
6	RW	0x0	DSP OUTPUT PIN den polarity invert 0: positive; 1: negative;
5	RW	0x0	DSP OUTPUT PIN VSYNC polarity invert 0: negative; 1: positive;
4	RW	0x0	DSP OUTPUT PIN HSYNC polarity invert 0: negative; 1: positive;
3:0	RW	0x0	Display output format: 4'b0000: Parallel 24-bit RGB888 output {R[7:0],G[7:0],B[7:0]} 4'b0001: Parallel 16-bit RGB666 output {6'b0,R[5:0],G[5:0],B[5:0]}

			<p>4'b0010: Parallel 15-bit RGB565 output $\{8'b0, R[4:0], G[5:0], B[4:0]\}$</p> <p>4'b0100: Serial 2x16-bit RGB888x $\{8'b0, G[7:0], B[7:0]\} + \{16'b0, R[7:0]\}$</p> <p>4'b0110: ITU-656 output $\{16'b0, pixel_data[7:0]\}$</p> <p>4'b1000: Serial 3x8-bit RGB888 $\{16'b0, B[7:0]\} + \{16'b0, G[7:0]\} + \{16'b0, R[7:0]\}$</p> <p>4'b1100: Serial 3x8-bit RGB888 + dummy $\{16'b0, B[7:0]\} + \{16'b0, G[7:0]\} + \{16'b0, R[7:0]\}$ + dummy</p> <p>Others: Reserved.</p>
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LCDC_DSP_CTRL_REG1

Address: Operational Base + offset (0x20)

LCDC display control register 1

bit	Attr	Reset Value	Description
31:26	-	-	reserved
25	RW	0x0	Black display mode. When this bit enable, the pixel data output is all black (0x000000)
24	RW	0x1	Blankdisplay mode. When this bit enable, the hsync/vsync/den output is blank
23:16	RW	0x00	Background Red color
15:8	RW	0x00	Background Green color
7:0	RW	0x00	Background Blue color

LCDC_INT_STATUS

Address: Operational Base + offset (0x24)

LCDC interrupt status register

bit	Attr	Reset Value	Description
31:20	-	-	Reserved.
19:9	RW	0x0	Line number of the scanning flaginterrupt The display line number when the flag interrupt occur, the range is (0~ DSP_VTOTAL-1).
8	W	0x0	Scanning flagInterrupt clear: After be set to 1, this bit will clear by itself 1 cycle later.
7	W	0x0	Frame start interrupt clear: After be set to 1, this bit will clear by itself 1 cycle later.
6	W	0x0	Horizontal start interrupt clear: After be set to 1, this bit will clear by itself 1 cycle later.
5	RW	0x1	Scanning flagInterrupt Mask: 0: unmask; 1: mask;
4	RW	0x1	Frame start interrupt mask: 0: unmask;

			1: mask; Horizontal start interrupt mask: 0: unmask; 1: mask;
3	RW	0x1	Horizontal start interrupt mask: 0: unmask; 1: mask;
2	R	0x0	Scanning flagInterrupt status
1	R	0x0	Frame start interrupt status
0	R	0x0	Horizontal start interrupt status

LCDC_WIN0_VIR

Address: Operational Base + offset (0x28)

LCDC win0 virtual width/height registers for Virtual display

bit	Attr	Reset Value	Description
31:16	-	-	Reserved.
15:0	RW	0x0	Win0 Virtual Display Width

LCDC_WIN0_YRGB_MST

Address: Operational Base + offset (0x2C)

LCDC win0 YRGB active frame buffer memory start address

bit	Attr	Reset Value	Description
31:0	RW	0x0000	win0 YRGB frame buffer memory start address

LCDC_WIN0_CBR_MST

Address: Operational Base + offset (0x30)

LCDC win0 CBR active frame buffer memory start address

bit	Attr	Reset Value	Description
31:0	RW	0x0000	win0 CBR frame buffer memory start address

LCDC_WIN0_ACT_INFO

Address: Operational Base + offset (0x34)

LCDC win0 active display width/height

bit	Attr	Reset Value	Description
31:16	W/R	0x0000	Win0 active(original) window height
15:0	W/R	0x0000	Win0 active(original) window width

LCDC_WIN0_DSP_ST

Address: Operational Base + offset (0x38)

LCDC win0 display start point

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	W/R	0x00	Win0 vertical start point(y)of the Panel scanning
15:11	-	-	Reserved.
10:0	W/R	0x00	Win0 horizontal start point(x) of the Panel scanning

LCDC_WIN0_DSP_INFO

Address: Operational Base + offset (0x3C)

LCDC win0 display width/height

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	W/R	0x00	Win0 display height on the Panel
15:11	-	-	Reserved.
10:0	W/R	0x00	Win0 display width on the Panel.

LCDC_WIN1_VIR

Address: Operational Base + offset (0x40)

LCDC win1 virtual width/height register for Virtual display

bit	Attr	Reset Value	Description
31:16	-	-	Reserved.
15:0	RW	0x00	Win1 Virtual Display Width

LCDC_WIN1_MST

Address: Operational Base + offset (0x44)

LCDC win1 active frame buffer memory start address

bit	Attr	Reset Value	Description
31:0	RW	0x0000	Win1 RGB frame buffer memory start address

LCDC_WIN1_DSP_INFO

Address: Operational Base + offset (0x48)

LCDC win1 active display width/height

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	W/R	0x0000	Win1dsp window height
15:11	-	-	Reserved.
10:0	W/R	0x0000	Win1dsp window width

LCDC_WIN1_DSP_ST

Address: Operational Base + offset (0x4c)

LCDC win1 display start point

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	W/R	0x00	Win1vertical start point(y)of the Panel scanning
15:11	-	-	Reserved.
10:0	W/R	0x00	Win1 horizontal start point(x)of the Panel scanning

LCDC_WIN2_MST

Address: Operational Base + offset (0x50)

LCDC win2 active frame buffer memory start address

bit	Attr	Reset Value	Description
31:0	RW	0x0000	Win2 frame buffer memory start address *must be aliased to 8byte address

LCDC_WIN2_DSP_INFO

Address: Operational Base + offset (0x54)

LCDC win2 active display width/height

bit	Attr	Reset Value	Description
31:16	W/R	0x0000	Win2dsp window height
15:0	W/R	0x0000	Win2dsp window width

LCDC_WIN2_DSP_ST

Address: Operational Base + offset (0x58)

LCDC win2 display start point

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	W/R	0x00	Win2vertical start point(y)of the Panel scanning
15:11	-	-	Reserved.

10:0	W/R	0x00	Win2 horizontal start point(x)of the Panel scanning
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LCDC_HWC_MST

Address: Operational Base + offset (0x5C)

LCDC HWC data memory start address

bit	Attr	Reset Value	Description
31:0	RW	0x0000	HWC data memory start address

LCDC_HWC_DSP_ST

Address: Operational Base + offset (0x60)

LCDC HWC display start point

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	RW	0x00	HWC vertical start point(y)of the Panel scanning
15:11	-	-	Reserved.
10:0	RW	0x00	HWC horizontal start point(x)of the Panel scanning

LCDC_HWC_COLOR_LUTO

Address: Operational Base + offset (0x64)

LCDC HWC color 0 look-up table

bit	Attr	Reset Value	Description
31:24	-	-	Reserved.
23:16	RW	0x00	Hardware cursor color red for 2'b00
15:8	RW	0x00	Hardware cursor color green for 2'b00
7:0	RW	0x00	Hardware cursor color blue for 2'b00

LCDC_HWC_COLOR_LUT1

Address: Operational Base + offset (0x68)

LCDC HWC color 1 look-up table

bit	Attr	Reset Value	Description
31:24	-	-	Reserved.
23:16	RW	0x00	Hardware cursor color red for 2'b01
15:8	RW	0x00	Hardware cursor color green for 2'b01
7:0	RW	0x00	Hardware cursor color blue for 2'b01

LCDC_HWC_COLOR_LUT2

Address: Operational Base + offset (0x6C)

LCDC HWC color 2 look-up table

bit	Attr	Reset Value	Description
31:24	-	-	Reserved.
23:16	RW	0x00	Hardware cursor color red for 2'b10
15:8	RW	0x00	Hardware cursor color green for 2'b10
7:0	RW	0x00	Hardware cursor color blue for 2'b10

LCDC_DSP_HTOTAL_HS_END

Address: Operational Base + offset (0x70)

LCDC Panel scanning timing register (Horizontal period, hsync pulse width)

bit	Attr	Reset Value	Description
31:28	-	-	Reserved.
27:16	RW	0x17f	Panel display scanning horizontal period.
15:12	-	-	Reserved.
11:0	RW	0x17	Panel display scanning hsync pulse width.

LCDC_DSP_HACT_ST_END

Address: Operational Base + offset (0x74)

LCDC Panel scanning timing register (horizontal active start/end point)

bit	Attr	Reset Value	Description
31:28	-	-	Reserved.
27:16	RW	0x2B	Panel display scanning horizontal active start point
15:12	-	-	Reserved.
11:0	RW	0x16A	Panel display scanning horizontal active end point

LCDC_DSP_VTOTAL_VS_END

Address: Operational Base + offset(0x78)

LCDC Panel scanning timing register(Verticalperiod, vsync pulse width)

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	RW	0x107	Panel display scanning verticalperiod.
15:11	-	-	Reserved.
10:0	RW	0x002	Panel display scanning vsync pulse width.

LCDC_DSP_VACT_ST_END

Address: Operational Base + offset (0x7C)

LCDC Panel scanning timing register (Verticalactive start/end point)

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	RW	0x00D	Panel display scanning verticalactive start point
15:11	-	-	Reserved.
10:0	RW	0x0FC	Panel display scanning vertical active end point

LCDC_DSP_VS_ST_END_F1

Address: Operational Base + offset (0x80)

LCDC Panelscanning timing register (Verticalvsync pulse start and end of interlace mode)

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	RW	0x00D	Panel display scanning verticalvsync start point of 2nd field (interlace display mode)
15:11	-	-	Reserved.
10:0	RW	0x0FC	Panel display scanning verticalvsync end point of 2nd field(interlace display mode)

LCDC_DSP_VACT_ST_END_F1

Address: Operational Base + offset (0x84)

LCDC Panelscanning timing register (Verticalactive start and end of interlace mode)

bit	Attr	Reset Value	Description
31:27	-	-	Reserved.
26:16	RW	0x00D	Panel display scanningverticalactive start point of 2nd field (interlace display mode)
15:11	-	-	Reserved.
10:0	RW	0x0FC	Panel display scanning verticalactive end point of 2nd field (interlace display mode)

LCDC_WIN0_SCL_FACTOR_Y

Address: Operational Base + offset (0x88)

LCDC win0 scaling factor of Y or RGB

bit	Attr	Reset Value	Description
31:16	RW	0x1000	Win0 YRGB vertical scaling factor: $factor = \left(\frac{LCDC_WIN0_ACT_INFO[31:16]}{LCDC_WIN0_DSP_INFO[31:16]} \right) \times 2^{12}$
15:0	RW	0x1000	Win0 YRGB horizontal scaling factor: $factor = \left(\frac{LCDC_WIN0_ACT_INFO[15:0]}{LCDC_WIN0_DSP_INFO[15:0]} \right) \times 2^{12}$

LCDC_WIN0_SCL_FACTOR_CBR

Address: Operational Base + offset (0x8C)

LCDC win0 scaling factor of CbCr

bit	Attr	Reset Value	Description
31:16	RW	0x1000	Win0 CBR vertical scaling factor: YCbCr420: $factor = \left(\frac{LCDC_WIN0_ACT_INFO[31:16]/2}{LCDC_WIN0_DSP_INFO[31:16]} \right) \times 2^{12}$ YCbCr422,YCbCr444: $factor = \left(\frac{LCDC_WIN0_ACT_INFO[31:16]}{LCDC_WIN0_DSP_INFO[31:16]} \right) \times 2^{12}$
15:0	RW	0x1000	Win0 CBR horizontal scaling factor: YCbCr422,YCbCr420: $factor = \left(\frac{LCDC_WIN0_ACT_INFO[15:0]/2}{LCDC_WIN0_DSP_INFO[15:0]} \right) \times 2^{12}$ YCbCr444: $factor = \left(\frac{LCDC_WIN0_ACT_INFO[15:0]}{LCDC_WIN0_DSP_INFO[15:0]} \right) \times 2^{12}$

LCDC_WIN0_SCL_OFFSET

Address: Operational Base + Offset(0x90)

Win0 Cbr scale offset.

bit	Attr	Reset Value	Description
31:24	RW	0x0	Cbr_v_offset <i>Cbr Vertical scaling start point offset</i> $(0x00\sim0xff)/0x100 = 0\sim0.99$
23:16	RW	0x0	Y_v_offset <i>Y Vertical scaling start point offset</i> $(0x00\sim0xff)/0x100 = 0\sim0.99$
15:8	RW	0x0	Cbr_h_offset <i>Cbr Horizontal scaling start point offset</i> $(0x00\sim0xff)/0x100 = 0\sim0.99$
7:0	RW	0x0	Y_h_offset <i>Y Horizontal scaling start point offset</i> $(0x00\sim0xff)/0x100 = 0\sim0.99$

LCDC_FIFO_WATER_MARK

Address: Operational Base + Offset(0x94)

bit	Attr	Reset Value	Description
31:16	-	-	Reserved

15:9	RW	0x70	Win2 fifo almost full level(128x64bit)
8:0	RW	0x1f0	Win1 fifo almost full level(512x64bit)

LCDC_AXI_MS_ID

Address: Operational Base + Offset(0x98)

AXI master ID

bit	Attr	Reset Value	Description
31:20	-	-	Reserved
19:16	RW	0x5	hwc channel ID
15:12	RW	0x4	Win2 channel ID
11:8	RW	0x3	Win1 YRGB channel ID
7:4	RW	0x2	Win0 Cbr channel ID
3:0	RW	0x1	Win0 YRGB channel ID

Note: Idle ID is 0, all the channel ID can't be 0;

LCDC_REG_CFG_DONE

Address: Operational Base + offset(0xa0)

LCDC register config done flag

bit	Attr	Reset Value	Description
31:1	-	-	Reserved.
0	W	0x0	In the first setting of the register, the new value was saved into the mirror register. When all the register config finish, writing this register to enable the copyright of the mirror register to real register. Then register would be updated at the start of every frame.

LCDC MCU BYPASS_WPORT

Address: Operational Base + offset(0x100)

LCDC MCU bypass mode data write port

bit	Attr	Reset Value	Description
31:0	W	-	When MCU is in BYPASS Mode, BYPASS data is writtenthrough this Port

LCDC MCU BYPASS_RPORT

Address: Operational Base + offset(0x200)

LCDC MCU bypass mode data read port

bit	Attr	Reset Value	Description
31:0	W	-	When MCU is in BYPASS Mode, BYPASS data is readthrough this Port (addr fixed)

LCDC_Win2_LUT_ADDR

Address: Operational Base + offset(0x400~0x7ff)

LCDC win2 lut bus access address map

bit	Attr	Reset Value	Description
31:0	RW	-	Access entry for win2 LUT memory(size is word only)

LCDC_DSP_LUT_ADDR

Address: Operational Base + offset(0x800~0xbff)

LCDC dsp lut bus access address map

bit	Attr	Reset Value	Description
31:0	RW	-	Access entry for DSP LUT memory(size is word only)

22.5 Timing Diagram

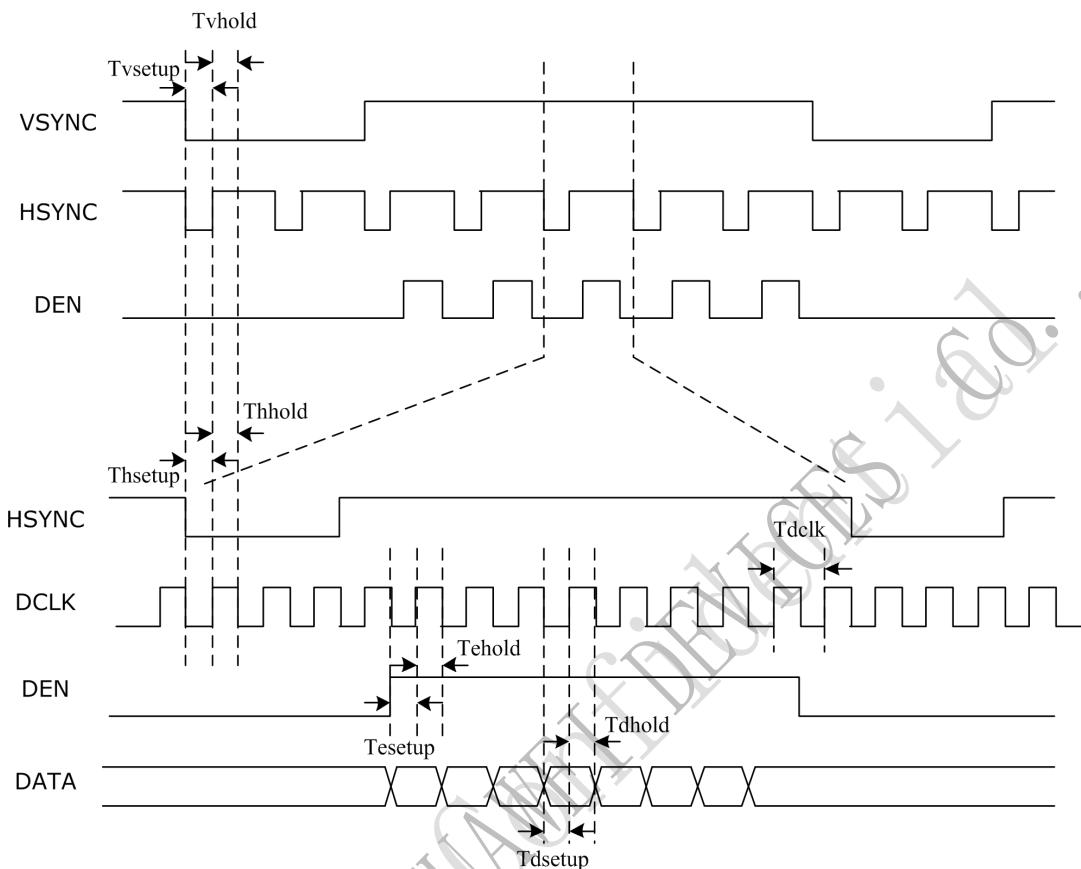


Fig. 22-16 LCDC RGB interface timing

Table 22-6 LCDC0 RGB interface signal timing constant

(VDD_core = 0.9V to 1.1V, VDD_IO = 3.0V to 3.6V, TA = -40°C to 125°C)

Item	Symbol	Min	Typ	Max	Unit
Display clock period	Tdclk	6.66	-	-	ns
VSYNC setup to DCLK falling edge	Tvsetup	2.941	2.706	2.217	ns
VSYNC hold from DCLK falling edge	Tvhold	2.934	2.911	3.084	ns
HSYNC setup to DCLK falling edge	Thsetup	2.905	2.651	2.162	ns
HSYNC hold from DCLK falling edge	Thhold	2.921	2.895	3.079	ns
DEN setup to DCLK falling edge	Tesetup	2.942	2.695	2.209	ns
DEN hold from DCLK falling edge	Tehold	2.927	2.913	3.077	ns
DATA setup to DCLK falling edge	Tdsetup	2.985	2.752	2.278	ns
DATA hold from DCLK falling edge	Tdhold	2.743	2.644	2.698	ns

Table 22-7 LCDC1 RGB interface signal timing constant

(VDD_core =0.9V to 1.1V, VDD_IO=3.0V to 3.6V , TA = -40°C ot 125°C)

Item	Symbol	Min	Typ	Max	Unit
Display clock period	Tdclk	6.66	-	-	ns
VSYNC setup to DCLK falling edge	Tvsetup	2.793	2.511	1.945	ns
VSYNC hold from DCLK falling edge	Tvholt	2.972	2.986	3.181	ns
Hsync setup to DCLK falling edge	Thsetup	2.862	2.597	2.080	ns
Hsync hold from DCLK falling edge	Thhold	2.947	2.946	3.130	ns
DEN setup to DCLK falling edge	Tesetup	2.916	2.672	2.174	ns
DEN hold from DCLK falling edge	Tehold	2.914	2.906	3.084	ns
DATA setup to DCLK falling edge	Tdsetup	2.901	2.628	2.114	ns
DATA hold from DCLK falling edge	Tdhold	2.762	2.717	2.773	ns

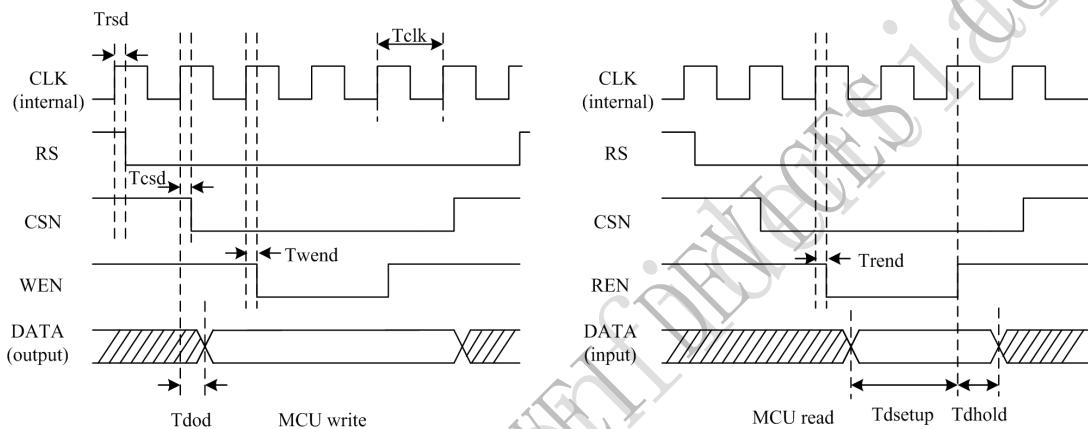


Fig. 22-17 LCDC MCU interface (i80)timing

Table 22-8 LCDC0 RGB interface signal timing constant

(VDD_core =0.9V to 1.1V, VDD_IO=3.0V to 3.6V , TA = -40°C ot 125°C)

Item	Symbol	Min	Typ	Max	Unit
Internal clock period	Tclk	6.64	-	-	ns
RS delay from CLK rising edge	Trsd				ns
CSN delay from CLK rising edge	Tcsd				ns
WEN delay from CLK rising edge	Twend				ns
REN delay from CLK rising edge	Trend				ns
D_out delay from CLK rising edge	Tdod				ns
D_in setup to REN rising edge	Tdsetup				ns
D_in hold from REN rising edge	Tdhold				ns

Table 22-9 LCDC1 RGB interface signal timing constant

(VDD_core =0.9V to 1.1V, VDD_IO=3.0V to 3.6V , TA = -40°C ot 125°C)

Item	Symbol	Min	Typ	Max	Unit
Internal clock period	Tclk	6.64	-	-	ns
RS delay from CLK rising edge	Trsd				ns
CSN delay from CLK rising edge	Tcsd				ns
WEN delay from CLK rising edge	Twend				ns
REN delay from CLK rising edge	Trend				ns
D_out delay from CLK rising edge	Tdod				ns
D_in setup to REN rising edge	Tdsetup				ns

D_in hold from REN rising edge	Tdhold					ns
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22.6 Interface Description

22.6.1 LCDC0 IOs

There are separate IOs for LCDC0.

22.6.2 LCDC1 IOs

The IOMUX for LCDC1 IOs see following table.

Table 22-10 LCDC1 IOMUX

Module Pin	Direction	Pad Name	IOMUX Setting
LCDC_DCLK	O	IO_GPIO2_D[0]	GRF_GPIO2D_IOMUX[1:0]=2'b01
LCDC_DEN	O	IO_GPIO2_D[1]	GRF_GPIO2D_IOMUX[3:2]=2'b01
LCDC_HSYNC	O	IO_GPIO2_D[2]	GRF_GPIO2D_IOMUX[5:4]=2'b01
LCDC_VSYNC	O	IO_GPIO2_D[3]	GRF_GPIO2D_IOMUX[7:6]=2'b01
LCDC_DATA[23:0]	I/O	{IO_GPIO2_C[7:0], IO_GPIO2_B[7:0], IO_GPIO2_A[7:0]}	GRF_GPIO2C_IOMUX[15:0] =16'h5555 GRF_GPIO2B_IOMUX[15:0] =16'h5555 GRF_GPIO2A_IOMUX[15:0] =16'h5555

Notes: I=input, O=output, I/O=input/output, bidirectional

22.6.3 Pin Definition

Table 22-11 LCD output pin definition

Pin	RGB 24-bit mode	RGB 18-bit mode	RGB 16-bit mode	MCU mode	656 mode
LCDC_DCLK	DCLK	DCLK	DCLK	RS	DCLK
LCDC_VSYNC	VSYNC	VSYNC	VSYNC	CSN	-
LCDC_HSYNC	Hsync	Hsync	Hsync	WEN	-
LCDC_DEN	DEN	DEN	DEN	REN	-
LCDC_DATA [23:0]	DATA[23:0] = {R8,G8,B8}	DATA[17:0] = {R6,G6,B6}	DATA[15:0] = {R5,G6,B5}	DATA[23:0] DATA[17:0] DATA[15:0]	DATA[7:0]

*NOTE: In MCU mode, LCD_DCLK is used as RS signal of i80 interface, others, LCD_DCLK is used as lcdc output data clock, which can be inverted according the register setting.

22.6.4 RGB Interface

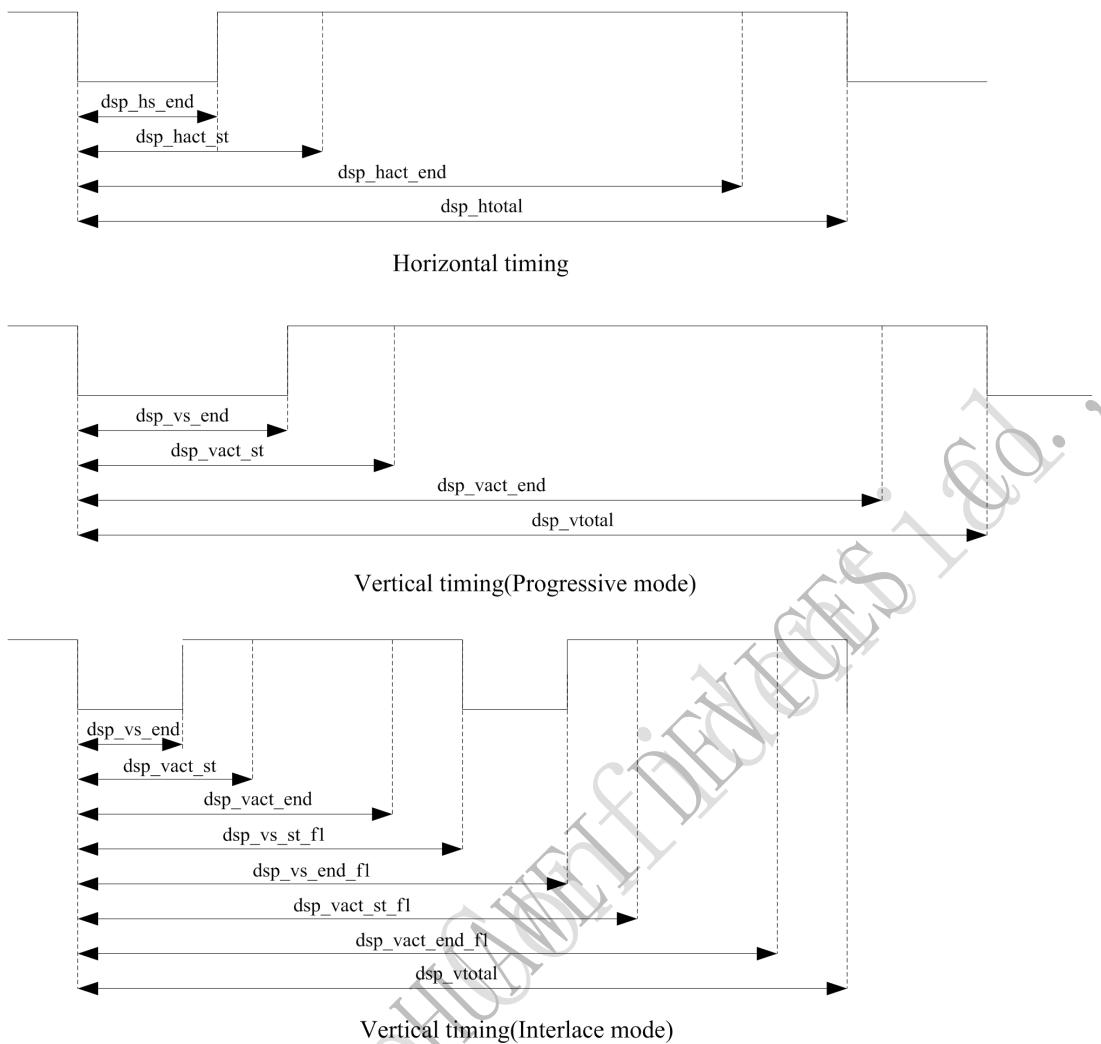


Fig. 22-18 LCDC RGB interface timing setting

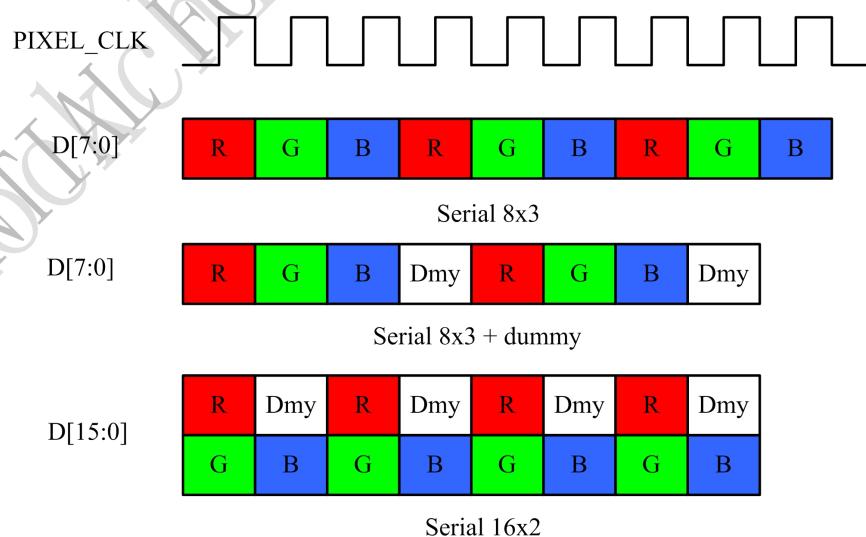


Fig. 22-19 LCDC Serial RGB LCD interface

22.6.5 MCU Interface (i80)

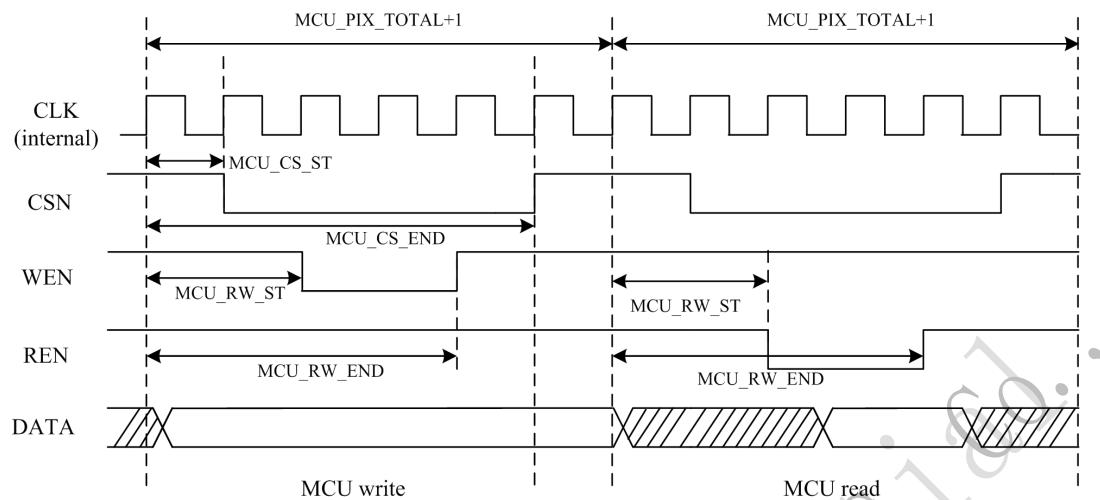


Fig. 22-20 LCDC MCU interface timing setting

22.6.6 RGB Delta Interface

RGB delta LCD handles serial 8bit data. In the case of RGB 8bit serial, there are four scanning modes for the RGB delta data.

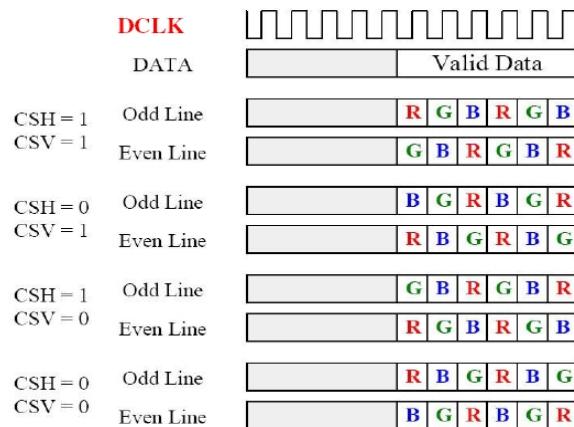


Fig. 22-21 LCDC RGB delta LCD interface

There are four setting modes for the four scanning modes of RGB delta LCD in LCD controller.

Table 22-12 LCDC delta and swap setting for RGB delta LCD

RGB delta mode	Delta_en	Dsp_rg_swap	Dsp_rb_swap	Dsp_bg_swap
CSH=1,CSV=1	1	0	1	0
CSH=0,CSV=1	1	0	0	0
CSH=1,CSV=0	1	0	0	1
CSH=0,CSV=0	1	0	1	1

Chapter 23 RGA

23.1 Overview

RGA is a separate 2D raster graphic acceleration unit. It accelerates 2D graphics operations, such as point/line drawing, image scaling, rotation, BitBLT, alpha blending and image blur/sharpness.

23.1.1 Features

◆ Data format

- Input data: ARGB/RGB888/RGB565/YUV420/YUV422
- Output data: ARGB/RGB888/RGB565 (YUV420/YUV422 for blur/sharpness)
- Pixel Format conversion, BT.601/BT.709
- Dither operation
- Max resolution: 8192x8192 source image, 2048x2048 frame buffer

◆ Scaling

- Down-scaling and up-scaling
- Three sampling modes: Nearest sampling (Stretched BitBLT), Bi-linear filter or Bi-cubic filter
- Arbitrary non-integer scaling ratio, from 1/2 to 8
- Average filter pre-scaling (2's Down-scaling bypass path, not available with other 2D operation)

◆ Rotation

- Arbitrary rotation, minimum 1 degree step
- No per-pixel alpha in arbitrary rotation (without 90, 180, 270)
- x-mirror, y-mirror

◆ BitBLT

- Block transfer
- Color palette (with transparency mode)/Color fill
- Transparency mode (color keying/stencil test, specified value/range)

◆ Alpha Blending

- Per-pixel/user-specified alpha blending (Porter-duff alpha support)
- Fading
- Anti-aliasing (for rotation)

◆ Raster operation

- ROP2/ROP3/ROP4
- No ROP in arbitrary rotation (except 90/180/270 degree)

◆ Line/Point drawing

- Bresenham algorithm, Specified width
- Anti-aliasing

◆ Blur/sharpness

- Bypass post processing path (not available with other 2D operation)
- Tile-based

For detailed information about **RGA**, please refer to **RK3168 RGA.pdf**.

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Chapter 24 Camera Interface

24.1 Overview

The Camera interface, receives the data from Camera or CCIR656 encoder, and transfers the data into system main memory by AXI bus.

The features of camera interface are as follow:

- Support YCbCr422 input
- Support Raw8/10/12 bit input
- Support CCIR656(PAL/NTSC) input
- Support JPEG input
- Support YCbCr422/420 output
- Support UYVY/VYUY/YUYV/YVYU configurable
- Support up to 8192x8192 resolution source
- Support picture in picture
- Support arbitrary size window crop
- Support scale range from 1/8 to 8, and destination width up to 1920
- Support SCM with configurable statistics cycles
- Support white balance
- Support error/terminate interrupt and combined interrupt output
- Support clk/vsync/href polarity configurable
- Support one frame stop/ping-pong/line loop mode

24.2 Block Diagram

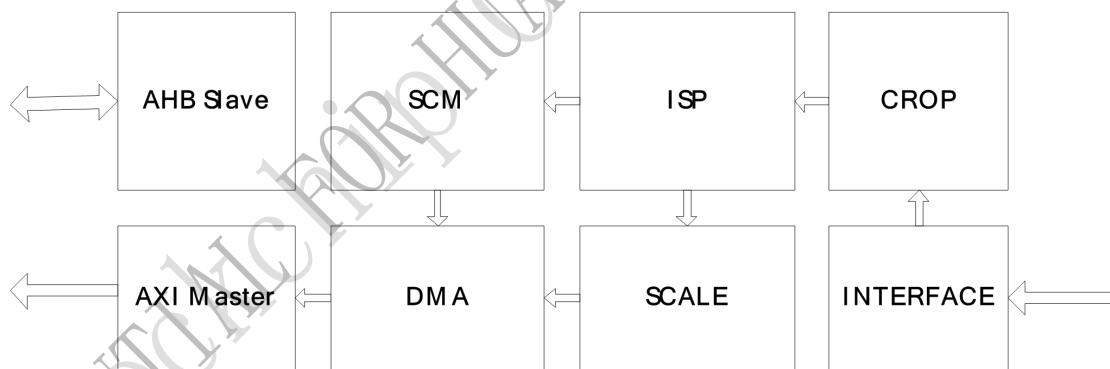


Fig. 24- 1CIF block diagram

The CIF comprises with:

- AHB Slave
Host configure the registers via the AHB Slave
- AXI Master
Transmit the data to chip memory via the AXI Master
- INTERFACE
Translate the input video data into the requisite data format
- CROP
Bypass or crop the source video data to a smaller size destination
- ISP
Modify the pixel value for more good visual effect
- SCM

- Collect the statistics of the pixel value
- SCALE
Scale up or down the input video data
- DMA
Control the operation of AXI Master

24.3 Function description

This chapter is used to illustrate the operational behavior of how CIF works. CIF receive the sensor, ccir656 signal from external devices and translate it into YUV422/420 data, separate the data to Y and UV data, then store them to different memory via AXI bus separately.

Input data format

The CIF module support the 8bit YUV422 and CCIR656, 10/12-bit raw data input.

1. Support Vsync high active or low active

- Vsync Low active as below:

Vertical sensor timing (line by line)

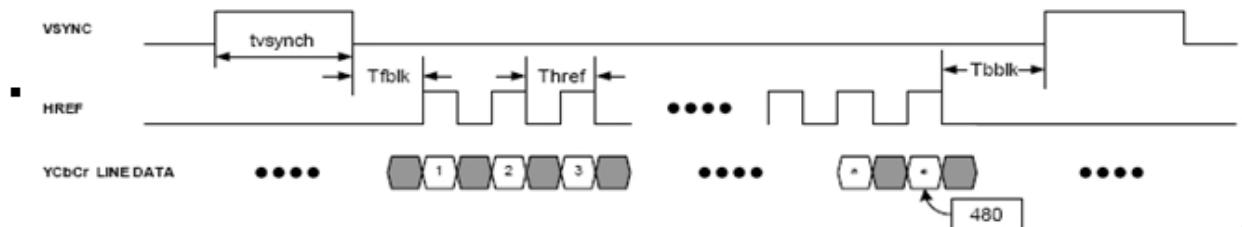


Fig. 24- 2 Timing diagram for CIF when vsync low active

- Vsync High active :

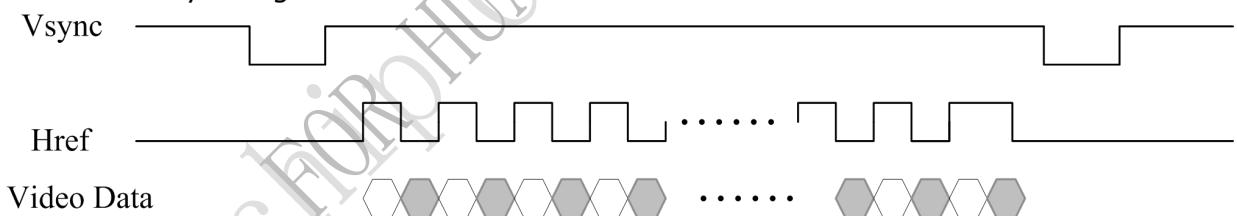


Fig. 24- 3 Timing diagram for CIF when vsync high active

2. Support href high active or low active

- Href high active:

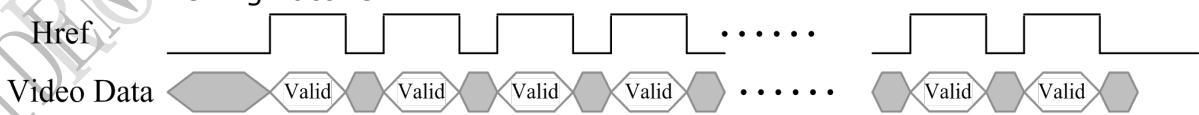


Fig. 24- 4 Timing diagram for CIF when href high active

- Href Low active

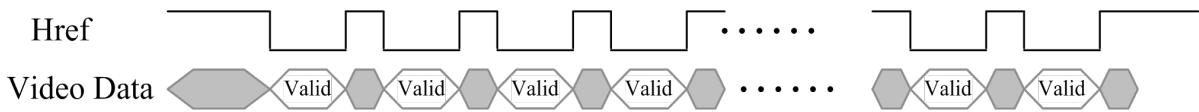


Fig. 24- 5 Timing diagram for CIF when href low active

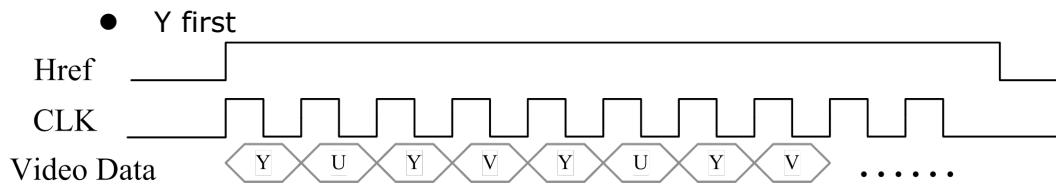


Fig. 24- 6 Timing diagram for CIF when Y data first

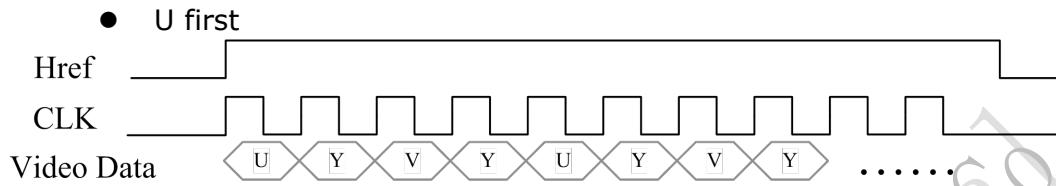


Fig. 24- 7 Timing diagram for CIF when U data first

3. Support CCIR656 (NTSC and PAL)

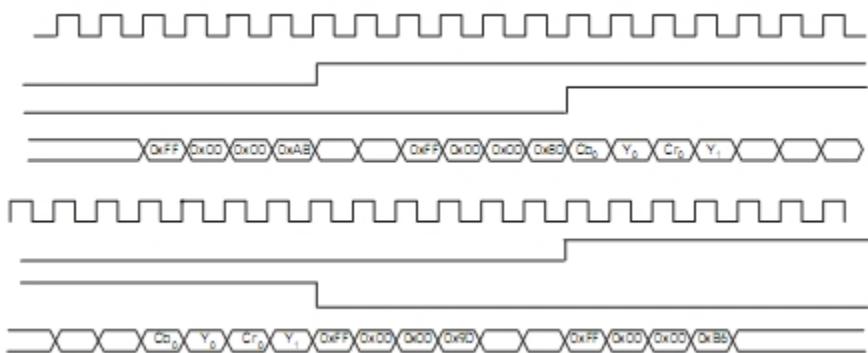


Fig. 24- 8 CCIR656 timing

4. Support Raw data(10/12-bit) or JPEG

Pixel Data Timing Example

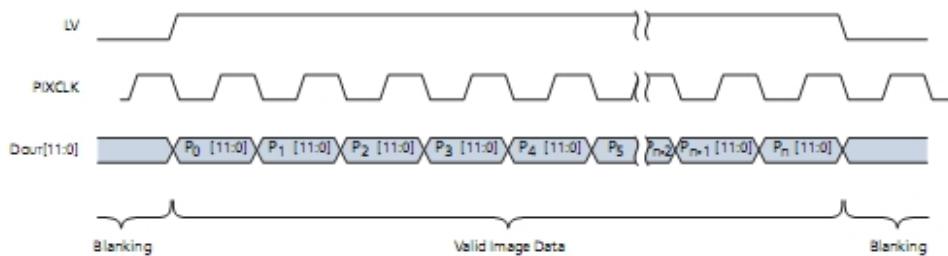


Fig. 24- 9 Raw Data or JPEG Timing

CIF module can work in three modes: one frame stop mode, ping-pong mode and Line Loop mode.

One frame stop mode

In this mode, configure the parameter WORK_MODE to one frame stop mode. After one frame captured, CIF will automatic stop. After capturing, the image Y, UV data will be stored at main memory location defined by CIF_FRM0_ADDR_Y, CIF_FRM0_ADDR_UV separately.

Ping-Pong mode

After one frame(F1) captured, CIF will start to capture the next frame(F2) automatically, and host must assign new address pointer of frame1 and clear the frame1 status, thus CIF will capture the third frame automatically(by new F1 address) without any stop and so on for the following frames. But if host did not update the frame buffer address, the CIF will cover the pre-frame data stored in the memory with the following frame data.

Line Loop mode

In this mode, LINE_LOOP_NUM can be set to decide when to switch the ping-pong buffer address at the middle of a frame. For example, if this parameter is equal to ten, the first ten lines is written to FRM0_ADDR_Y and FRM0_ADDR_UV. And the second ten lines are written to FRM1_ADDR_Y and FRM1_ADDR_UV. The third ten lines, the fourth ten lines, it runs like this in circulations.

Assume that there are 384 lines in the frame, the FRAME_END_SWITCH can be set to switch the frame buffer address at the end of the frame although less than ten lines written in the frame buffer. But if the FRAME_END_SWITCH bit is not set, the address switching operation will occur after the first six lines in the next frame are written in the current frame buffer.

The current line number of the frame can be written to LIN_NUM_ADDR if ISSUE_LINE_NUM_MODE is enabled.

Storage

Difference between the YUV mode and raw mode is that in the YUV mode or ccir656 mode, data will be storage in the Y data buffer and UV data buffer; but in the raw or jpeg mode, RGB data will be storage in the same buffer. In addition, in the yuv mode, the width of Y, U or V data is a byte in memory; in Raw or JPEGE mode, the width is a halfword no matter the data source is 8 bit, 10 bit or 12 bit.

CROP

The parameter START_Y and START_X defines the coordinate of crop start point. And the frame size after cropping is following the value of SET_WIDTH and SET_HEIGHT.

ISP

The ISP LUT RAM address offset is range from 0x1000 to 0x13FC and bits [1:0] must be 2'b0. There are 256 RAM entries and [23:16], [15:8], [7:0] bits of data in each entry correspond to Y, U, V separately.

The function of ISP operation is mapping the input YUV value to output YUV value based on the ISP LUT RAM. The input YUV value is the address of LUT RAM, and the output value is the data in the input address. After reset, there are invalid values in LUT RAM. It is recommend to initialize the LUT RAM before doing ISP operation.

The configuration flow is the following. Firstly, set the ISP_INIT_LD bit and initialize the ISP LUT RAM for the pixel value mapping. The ISP_EN can be set only if the initializing operation is ready.

SCM

Just like the ISP operation flow, the first task of SCM operation is writing 1 to SCM_INIT_LD bit. Next, it is recommended to initialize the SCM RAM to all zero. After that, SCM_EN can be enabled to start to collect the statistics of the pixel value.

The SCM frequency is also configurable. The frequency of pixel is controlled by

PIX_SAMPLE_FREQ.And the frequency of frame is controlled by FRM_SAMPLE_FREQ.

The SCM result can be read by AXI Master or AHB Slave.In AHB Slave mode,only one frame can be collected and the result will be absolutely right.But if the AXI Master mode is selected, SCM error maybe occur when the SCM information of previous frame is not reading completely but current frame is coming.

The SCM RAM address is word address and the offset is the following:

Y: 0x400~0x7FC

U: 0x800~0xBFC

V: 0xC00~0xFFC

WBC

When all of the following conditions is true, the pixels will be counted in the resiter WBC_CNT.

MAX_Y < y value < MIN_Y

MAX_U < u value < MIN_U

MAX_V < v value < MIN_V

SCALE

The scale source size is SET_WIDTH and SET_HEIGHT, the scale destination size is SCL_WIDTH and SCL_HEIGHT.And the scale factor must be set correctly ,or scale error may be occurred.

SCL_HOR_FCT = ((src_width-1)/(dst_width-1)) * 2¹²

SCL_VER_FCT =((src_height-1)/(dst_height -1)) * 2¹²

24.4 Register description

24.4.1 Register Summary

Name	Offset	Size	Reset Value	Description
CIF_CIF_CTRL	0x0000	W	0x00007000	CIF control
CIF_CIF_INTEN	0x0004	W	0x00000000	CIF interrupt enable
CIF_CIF_INTSTAT	0x0008	W	0x00000000	CIF interrupt status
CIF_CIF_FOR	0x000c	W	0x00000000	CIF format
CIF_CIF_LINE_NUM_ADDR	0x0010	W	0x00000000	CIF line number address
CIF_CIF_FRM0_ADDR_Y	0x0014	W	0x00000000	CIF frame0 y address
CIF_CIF_FRM0_ADDR_UV	0x0018	W	0x00000000	CIF frame0 uv address
CIF_CIF_FRM1_ADDR_Y	0x001c	W	0x00000000	CIF frame1 y address
CIF_CIF_FRM1_ADDR_UV	0x0020	W	0x00000000	CIF frame1 uv address
CIF_CIF_VIR_LINE_WIDTH	0x0024	W	0x00000000	CIF virtual line width
CIF_CIF_SET_SIZE	0x0028	W	0x01e002d0	CIF frame set size
CIF_CIF_SCM_ADDR_Y	0x002c	W	0x00000000	CIF scm y data address
CIF_CIF_SCM_ADDR_U	0x0030	W	0x00000000	CIF scm u data address
CIF_CIF_SCM_ADDR_V	0x0034	W	0x00000000	CIF scm v data address
CIF_CIF_WB_UP_FILTER	0x0038	W	0x00000000	CIF white balance up filter
CIF_CIF_WB_LOW_FILTER	0x003c	W	0x00000000	CIF white balance low filter

Name	Offset	Size	Reset Value	Description
CIF_CIF_WBC_CNT	0x0040	W	0x00000000	CIF white balance count
CIF_CIF_CROP	0x0044	W	0x00000000	CIF crop start point
CIF_CIF_SCL_CTRL	0x0048	W	0x00000000	CIF scale control
CIF_CIF_SCL_DST	0x004c	W	0x00000000	CIF scale destination frame size
CIF_CIF_SCL_FCT	0x0050	W	0x20002000	CIF scale factor
CIF_CIF_SCL_VALID_NUM	0x0054	W	0x00000000	CIF scale valid number
CIF_CIF_LINE_LOOP_CTRL	0x0058	W	0x00000000	CIF line loop control
CIF_CIF_FRAME_STATUS	0x0060	W	0x00000000	CIF frame status
CIF_CIF_CUR_DST	0x0064	W	0x00000000	CIF current destination address
CIF_CIF_LAST_LINE	0x0068	W	0x00000000	CIF last frame line number
CIF_CIF_LAST_PIX	0x006c	W	0x00000000	CIF last line pixel number

Notes:Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

24.4.2 Detail Register Description

CIF_CIF_CTRL

Address: Operational Base + offset (0x0000)

CIF control

Bit	Attr	Reset Value	Description
31:18	RO	0x0	reserved
17	RW	0x0	SCM_INIT_LD scm sram initial load 0-disable 1-load enable
16	RO	0x0	reserved
15:12	RW	0x7	AXI_BURST_TYPE axi master burst type 0-15 : burst1~16
11	RW	0x0	WBC_EN white balance collect 0-disable 1-enable
10	RW	0x0	ISP_EN isp enable 0-disable 1-enable

Bit	Attr	Reset Value	Description
9	RW	0x0	ISP_INIT_LD isp lut initial enable 0-disable 1-load enable
8	RW	0x0	SCM_RD_MODE scm read mode 0-AXI master 1-AHB slave Note: when in slave mode, only collect one frame.
7:6	RW	0x0	PIX_SAMPLE_FRQ pixel scm sample frequency 00 - none 01 - every 1 uv/2 y 10 - every 2 uv/4 y 11 - every 4 uv/8 y
5:4	RW	0x0	FRM_SAMPLE_FRQ frame SCM sample frequency 000 - every 1 frame 001 - every 2 frame 010 - every 3 frame 011 - every 4 frame
3	RW	0x0	SCM_EN SCM enable 0-SCM disable 1-SCM enable
2:1	RW	0x0	WORK_MODE Working Mode 00-one frame stop mode 01-ping-pong mode 02-line loop mode 03-reserved
0	RW	0x0	CAP_EN capture enable 0-disable 1-enable

CIF_CIF_INTEN

Address: Operational Base + offset (0x0004)
CIF interrupt enable

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved

Bit	Attr	Reset Value	Description
7	RW	0x0	SCL_ERR_EN scale error 0-disable 1-enable
6	RW	0x0	BUS_ERR_EN bus error axi master or ahb slave response error 0-disable 1-enable
5	RW	0x0	SCM_ERR_EN scm error scm start when the last scm data have not be send 0-disable 1-enable
4	RW	0x0	LINE_BUF_OVER_EN line buffer overflow 0-disable 1-enable
3	RW	0x0	PIX_ERR_EN pixel err interrupt enable the pixel number of last line not equal to the set height 0-disable 1-enable
2	RW	0x0	LINE_ERR_EN line err interrupt enable the line number of last frame not equal to the set height 0-disable 1-enable
1	RW	0x0	LINE_END_EN line end interrupt enable 0-disable 1-enable
0	RW	0x0	FRAME_END_EN frame end interrupt enable after dma transfer the frame data 0-disable 1-enable

CIF_CIF_INTSTAT

Address: Operational Base + offset (0x0008)
CIF interrupt status

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7	W1C	0x0	SCL_ERR scale error 0-no interrupt 1-interrupt
6	W1C	0x0	BUS_ERR bus error axi master or ahb slave response error 0-no interrupt 1-interrupt
5	W1C	0x0	SCM_ERR scm error scm start when the last scm data have not be send 0-no interrupt 1-interrupt
4	W1C	0x0	LINE_BUF_OVER line buffer overflow 0-no interrupt 1-interrupt
3	W1C	0x0	PIX_ERR pixel err interrupt the pixel number of last line not equal to the set height 0-no interrupt 1-interrupt
2	W1C	0x0	LINE_ERR line err interrupt the line number of last frame not equal to the set height 0-no interrupt 1-interrupt
1	W1C	0x0	LINE_END line end interrupt enable 0-no interrupt 1-interrupt
0	W1C	0x0	FRAME_END frame end interrupt after dma transfer the frame data 0-no interrupt 1-interrupt

CIF_CIF_FOR

Address: Operational Base + offset (0x000c)

CIF format

Bit	Attr	Reset Value	Description
31:20	RO	0x0	reserved
19	RW	0x0	UV_STORE_ORDER UV storage order 0 - UVUV 1 - VUVU
18	RW	0x0	RAW_END raw data endian 0 - little end 1 - big end
17	RW	0x0	OUT_420_ORDER output 420 order 00 - UV in the even line 01 - UV in the odd line Note: The first line is even line(line 0).
16	RW	0x0	OUTPUT_420 output 420 or 422 0 - output is 422 1 - output is 420
15	RO	0x0	reserved
14:13	RW	0x0	MIPI_MODE mipi mode 00 - bypass 01 - rgb 10 - yuv 11- reserved
12:11	RW	0x0	RAW_WIDTH raw data width 00 - raw8 01 - raw10 10 - raw12 11 - reserved
10	RW	0x0	JPEG_MODE JPEG mode 0 - other mode 1 - mode1
9	RW	0x0	FIELD_ORDER ccir input order 0-odd field first 1-even field first

Bit	Attr	Reset Value	Description
8	RW	0x0	IN_420_ORDER 420 input order 00 - UV in the even line 01 - UV in the odd line Note: The first line is even line(line 0).
7	RW	0x0	INPUT_420 input 420 or 422 0 - 422 1 - 420
6:5	RW	0x0	YUV_IN_ORDER YUV input order 00 - UYVY 01 - YVYU 10 - VYUY 11 - YUYV
4:2	RW	0x0	INPUT_MODE input mode 000 - YUV 010 - PAL 011 - NTSC 100 - RAW 101 - JPEG 110 - MIPI Other - invalid
1	RW	0x0	HREF_POL href input polarity 0-high active 1-low active
0	RW	0x0	VSYNC_POL vsync input polarity 0-low active 1-high active

CIF_CIF_LINE_NUM_ADDR

Address: Operational Base + offset (0x0010)

CIF line number address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	LIN_NUM_ADDR line number address

CIF_CIF_FRM0_ADDR_Y

Address: Operational Base + offset (0x0014)

CIF frame0 y address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	FRM0_ADDR_Y frame0 y address

CIF_CIF_FRM0_ADDR_UV

Address: Operational Base + offset (0x0018)

CIF frame0 uv address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	FRM0_ADDR_UV frame0 uv address

CIF_CIF_FRM1_ADDR_Y

Address: Operational Base + offset (0x001c)

CIF frame1 y address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	FRM1_ADDR_Y frame1 y address

CIF_CIF_FRM1_ADDR_UV

Address: Operational Base + offset (0x0020)

CIF frame1 uv address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	FRM1_ADDR_UV frame1 uv address

CIF_CIF_VIR_LINE_WIDTH

Address: Operational Base + offset (0x0024)

CIF virtual line width

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14:0	RW	0x0000	VIR_LINE_WIDTH virtual line width

CIF_CIF_SET_SIZE

Address: Operational Base + offset (0x0028)

CIF frame set size

Bit	Attr	Reset Value	Description
31:29	RO	0x0	reserved
28:16	RW	0x01e0	SET_HEIGHT set height
15:13	RO	0x0	reserved
12:0	RW	0x02d0	SET_WIDTH set width

CIF_CIF_SCM_ADDR_Y

Address: Operational Base + offset (0x002c)

CIF scm y data address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	FRM_ADDR_Y frame y address

CIF_CIF_SCM_ADDR_U

Address: Operational Base + offset (0x0030)

CIF scm u data address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	FRM_ADDR_U frame u address

CIF_CIF_SCM_ADDR_V

Address: Operational Base + offset (0x0034)

CIF scm v data address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	FRM_ADDR_V frame v address

CIF_CIF_WB_UP_FILTER

Address: Operational Base + offset (0x0038)

CIF white balance up filter

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23:16	RW	0x00	MAX_Y max y value
15:8	RW	0x00	MAX_U max u value
7:0	RW	0x00	MAX_V max v value

CIF_CIF_WB_LOW_FILTER

Address: Operational Base + offset (0x003c)

CIF white balance low filter

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23:16	RW	0x00	MIN_Y min y value
15:8	RW	0x00	MIN_U min u value

Bit	Attr	Reset Value	Description
7:0	RW	0x00	MIN_V min v value

CIF_CIF_WBC_CNT

Address: Operational Base + offset (0x0040)

CIF white balance count

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23:0	RO	0x000000	WBC_CNT white balance count

CIF_CIF_CROP

Address: Operational Base + offset (0x0044)

CIF crop start point

Bit	Attr	Reset Value	Description
31:29	RO	0x0	reserved
28:16	RW	0x0000	START_Y start y point
15:13	RO	0x0	reserved
12:0	RW	0x0000	START_X start x point

CIF_CIF_SCL_CTRL

Address: Operational Base + offset (0x0048)

CIF scale control

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6	RW	0x0	B32_BP 32bit bypass 0-no bypass 1-bypass
5	RW	0x0	RAW_16B_BP raw 16 bit bypass 0-no bypass 1-bypass
4	RW	0x0	YUV_16B_BP YUV 16 bit bypass 0-no bypass 1-bypass
3:2	RO	0x0	reserved

Bit	Attr	Reset Value	Description
1	RW	0x0	SCL_UP_EN scale up enable 0:disable 1:enable
0	RW	0x0	SCL_DOWN_EN scale down control 0:disable 1:enable

CIF_CIF_SCL_DST

Address: Operational Base + offset (0x004c)

CIF scale destination frame size

Bit	Attr	Reset Value	Description
31:27	RO	0x0	reserved
26:16	RW	0x000	SCL_HEIGHT scale height
15:11	RO	0x0	reserved
10:0	RW	0x000	SCL_WIDTH scale width

CIF_CIF_SCL_FCT

Address: Operational Base + offset (0x0050)

CIF scale factor

Bit	Attr	Reset Value	Description
31:16	RW	0x2000	SCL_VER_FCT vertical scale factor $vrt_scl_fct = ((src_height-1)/(dst_height -1)) * 2^{13}$
15:0	RW	0x2000	SCL_HOR_FCT horizontal scale factor $hrz_scl_fct = ((src_width-1)/(dst_width -1)) * 2^{13}$

CIF_CIF_SCL_VALID_NUM

Address: Operational Base + offset (0x0054)

CIF scale valid number

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14:8	RW	0x00	SCL_VALID_NUM_UV scale valid number in Y FIFO write 0 clear
7	RO	0x0	reserved

Bit	Attr	Reset Value	Description
6:0	RO	0x00	SCL_VALID_NUM_Y scale valid number in Y FIFO write 0 clear

CIF_CIF_LINE_LOOP_CTRL

Address: Operational Base + offset (0x0058)

CIF line loop control

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5	RW	0x0	ISSUE_LINE_NUM_MODE issue line num mode 0-disable 1-enable
4	RW	0x0	FRAME_END_SWITCH frame end switch enable 0-disable 1-enable
3:0	RW	0x0	LINE_LOOP_NUM line loop num 1~16

CIF_CIF_FRAME_STATUS

Address: Operational Base + offset (0x0060)

CIF frame status

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	FRAME_NUM complete frame number write 0 to clear
15:2	RO	0x0	reserved
1	RO	0x0	F1_STS frame 0 status 0- frame 1 not ready 1- frame 1 ready write 0 clear
0	RO	0x0	F0_STS frame 0 status 0- frame 0 not ready 1- frame 0 ready write 0 clear

CIF_CIF_CUR_DST

Address: Operational Base + offset (0x0064)

CIF current destination address

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	CUR_DST current destination address May be not the current, because the clock synchronization.

CIF_CIF_LAST_LINE

Address: Operational Base + offset (0x0068)

CIF last frame line number

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13:0	RO	0x0000	LAST_LINE_NUM line number of last frame

CIF_CIF_LAST_PIX

Address: Operational Base + offset (0x006c)

CIF last line pixel number

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14:0	RO	0x0000	LAST_PIX_NUM pixel number of last line

24.5 Timing Diagram

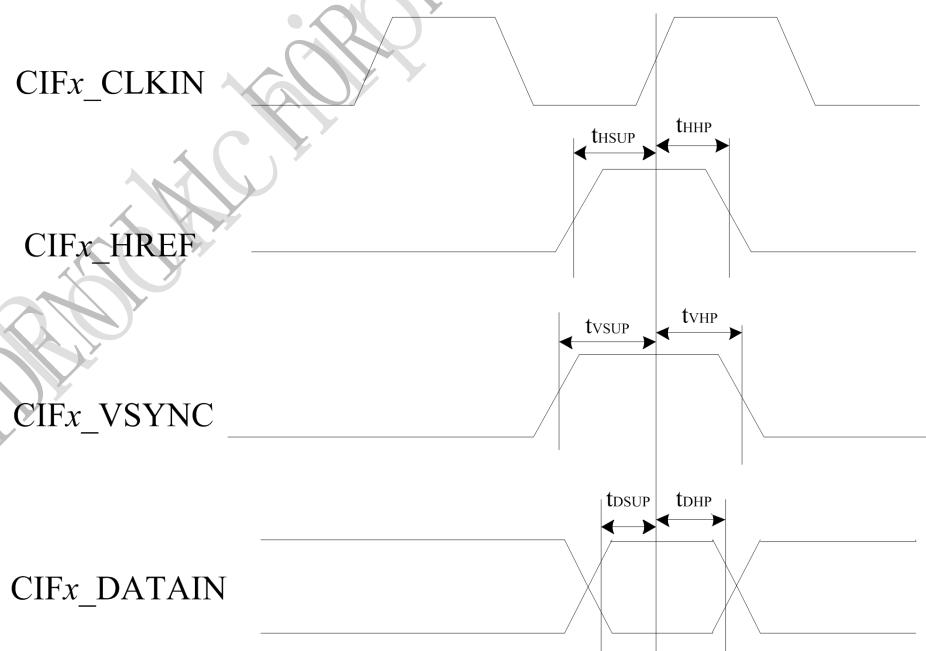


Table 24- 1CIF0 Timing

Symbol	Parameter	best	Typ.	worst	unit

		case	case	case	
t_{HSUP}	Input HREF setup time to CIF_CLKIN rising edge	0.308	0.266	0.187	ns
t_{HHP}	Input HREF hold time to CIF_CLKIN rising edge	0	0	0	ns
t_{VSUP}	Input VSYNC setup time to CIF_CLKIN rising edge	-0.301 1	-0.28	-0.253	ns
t_{VHP}	Input VSYNC hold time to CIF_CLKIN rising edge	0	0	0	ns
t_{DSUP}	Input DATAIN setup time to CIF_CLKIN rising edge	0.262	0.157	0.05	ns
t_{DHP}	Input DATAIN hold time to CIF_CLKIN rising edge	0	0	0	ns

24.6 Interface description

Module Pin	Direction	Pad Name	IOMUX Setting
CIFO			
cif_clkout	O	GPIO3_B[3]	GRF_GPIO3B_IOMUX[6]=1'b1
cif_clkin	I	CIFO_CLKIN	N/A
cif_href	I	CIFO_HREF	N/A
cif_vsync	I	CIFO_VSYNC	N/A
cif_data0	I	GPIO3_B[4]	GRF_GPIO3B_IOMUX[9:8]=2'b01
cif_data1	I	GPIO3_B[5]	GRF_GPIO3B_IOMUX[11:10]=2'b01
cif_data2	I	CIFO_DATAIN[2]	N/A
cif_data3	I	CIFO_DATAIN[3]	N/A
cif_data4	I	CIFO_DATAIN[4]	N/A
cif_data5	I	CIFO_DATAIN[5]	N/A
cif_data6	I	CIFO_DATAIN[6]	N/A
cif_data7	I	CIFO_DATAIN[7]	N/A
cif_data8	I	CIFO_DATAIN[8]	N/A
cif_data9	I	CIFO_DATAIN[9]	N/A
cif_data10	I	GPIO3_B[6]	GRF_GPIO3B_IOMUX[12]=2'b01
cif_data11	I	GPIO3_B[7]	GRF_GPIO3B_IOMUX[14]=2'b01

The valid data bits of different widths are the following:

- 8 bit: data2~data9;
- 10bit: data0~data9;
- 12bit: data0~data11;

24.7 Application Notes

There are two operations strongly depend on the configuration order: SCM and ISP.

The SCM configuration flow is:

- a. Write 1 to SCM_INIT_LD bit to make sure the SCM RAM can be written;
- b. Initialize all zero to the three 256x23 bit SCM RAM for Y/U/V statistics collection;
- c. Set SCM_EN to announce SCM configuration is ready.

The ISP configuration is very similar with SCM:

- a. Write 1 to ISP_INIT_LD bit to make sure the ISP RAM can be written;
- b. Initialize the ISP lut RAM for pixel value mapping.

c. Set ISP_EN to announce ISP configuration is ready.

The biggest configuration requirement of all operations is the CAP_EN bit must be set after all the mode selection is ready. The configuration order of the input/output data format, YUV order, the address ,frame size/width , AXI burst length and other options do not need to care.

There are many debug registers to make it easy to read the internal operation information of CIF. The valid pixel number of scale result in FIFO can be known by readCIF_CIF_SCL_VALID_NUM. The line number of last frame and the pixel number of last line can be also known by read the CIF_CIF_LAST_LINE and CIF_CIF_LAST_PIX.

Chapter 25 USB Host2.0

25.1 Overview

USB HOST2.0 supports host functions and is fully compliant with USB2.0 specification, and support high-speed(480Mbps),full-speed(12Mbps),low-speed(1.5Mbps) transfer. USB HOST 2.0 supports high-speed(480Mbps), full-speed(12Mbps), low-speed (1.5Mbps) transfer. It is optimized for point-to-point applications (no hub, direct connection to device).

25.1.1 Features

- Compliant with the USB2.0 Specification
- Operates in host mode
- Operates in High-Speed and Full-Speed mode
- Support 16 channels in host mode
- Built-in one 840x35 bits FIFO
- Internal DMA with scatter/gather function

25.2 Block Diagram

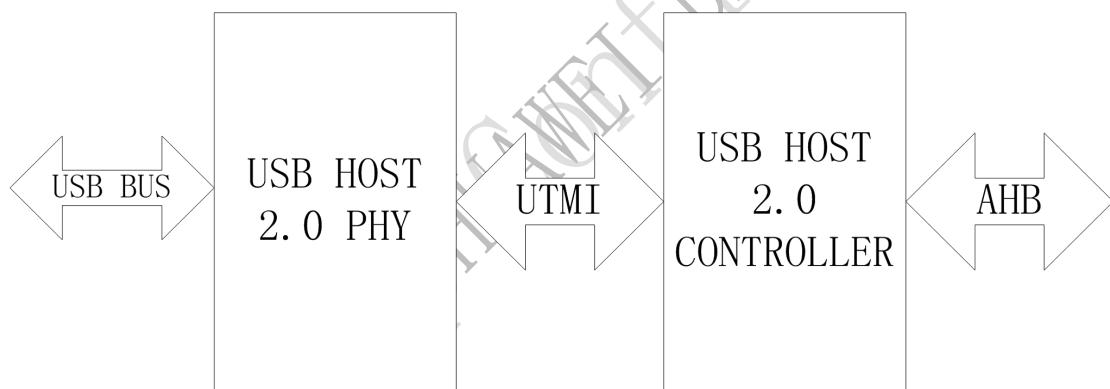


Fig. 25-1USB HOST 2.0 Architecture

Fig.26-1 shows the architecture of USB HOST 2.0. It is broken up into two separate units: USB HOST 2.0 controller and USB HOST 2.0 PHY. The two units are interconnected with UTMI interface.

25.2.1 USB HOST 2.0 Controller Function

The USB HOST 2.0 Controller controls SIE(Serial Interface Engine) Logic , the Channel logic and the internal DMA logic.

The SIElogic contains the USB PID and address recognition logic, and other sequencing and state machine logic to handle USB packets and transactions.

The Channel Logic contains the channel tasks schedule, FIFOs and FIFO control, etc.

The internal DMA logic controls data transaction between system memory and USB FIFOs.

25.2.2 USB HOST 2.0 PHY Function

The USB HOST 2.0 PHY handles the low level USB protocol and signaling. This includes features such as; dataserialization and deserialization, bit stuffing and clock recovery and synchronization. The primary focus of this block is to shift the clock domain of the data from the USB 2.0 rate to the frequency of UTMI clock which is 30MHz.

25.3 USB Host2.0 Controller

USB HOST Controller is a usb host controller, which supports both high-speed(480Mbps), full-speed(12Mbps) and is fully compliant with USB2.0 specification. This controller will support UTMI+ Level 3 PHY interface. It connects to the industry-standard AMBA AHB for communication with the application and system memory. And it is optimized for portable electronic device and point-to-point applications (no hub, direct connection to device) .

Fig.26-2 shows the architecture of USB HOST 2.0 Controller.

The host uses one transmit FIFO for all non-periodic OUT transactions and one transmit FIFO for all periodic OUT transactions. These transmit FIFOs are used as transmit buffers to hold the data (payload of the transmit packet) to be transmitted over USB. The host pipes the USB transactions through Request queues (one for periodic and one for non-periodic). Each entry in the Request queue holds the IN or OUT channel number along with other information to perform a transaction on the USB. The order in which the requests are written into the queue determines the sequence of transactions on the USB. The host processes the periodic Request queue first, followed by the non-periodic Request queue, at the beginning of each (micro)frame. The host uses one receive FIFO for all periodic and non-periodic transactions. The FIFO is used as a receive buffer to hold the received data (payload of the received packet) from the USB until it is transferred to the system memory. The status of each packet received also goes into the FIFO. The status entry holds the IN channel number along with other information, such as received byte count and validity status, to perform a transaction on the AHB.

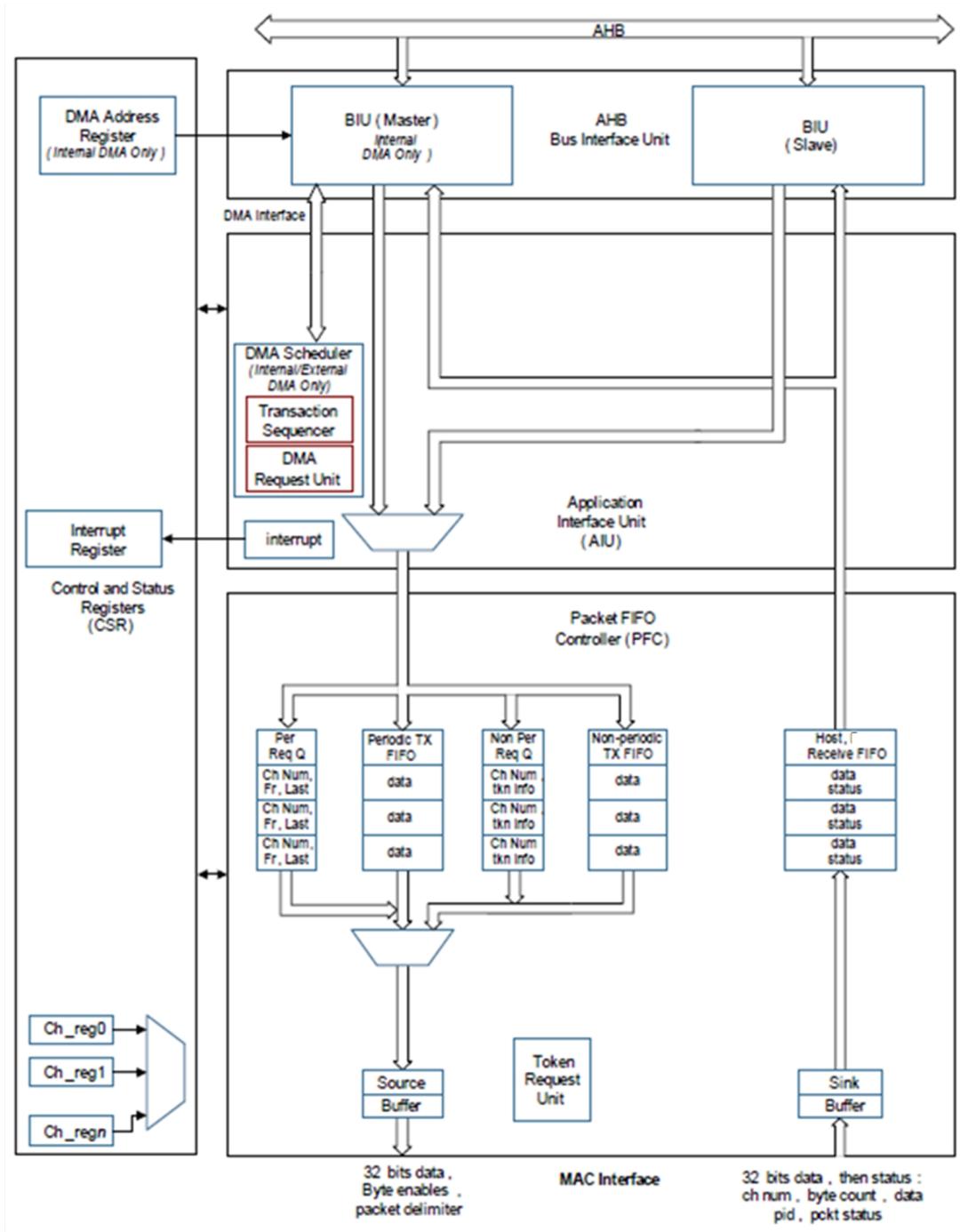


Fig. 25-2 USB HOST 2.0 Controller Architecture

25.4 USB Host2.0 PHY

The USB HOST 2.0 PHY connects a host controller to a USB system. It is a complete mixed-signal IP designed to implement USB connectivity in a System-on-Chip(SOC) design targeted to a specific fabrication process using core and 1.8-V thick-oxide devices. The USB 2.0 PHY supports the USB2.0 480-Mbps protocol and data rate, and is backward compatible with the USB 1.1 1.5-Mbps and 12-Mbps protocol and data rates.

25.4.1 Block Diagram

Fig.27-13 shows the USB HOST 2.0 PHY functional block diagram for a one-port macro.

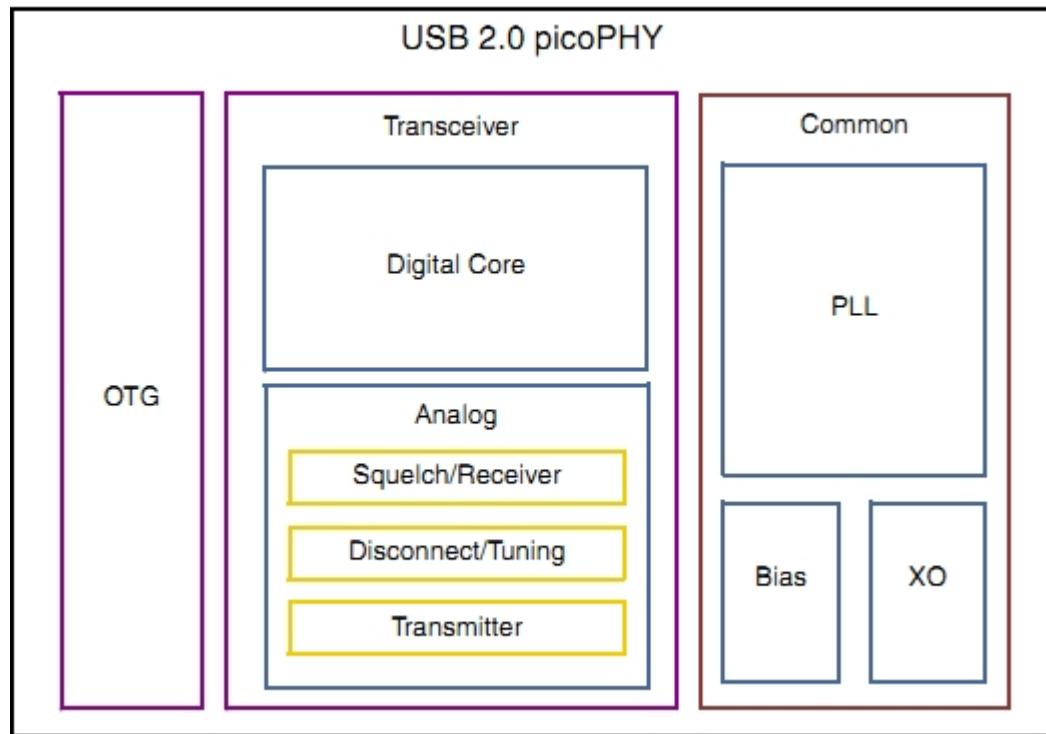


Fig. 25- 3 USB HOST 2.0 PHY Architecture

The USB HOST 2.0 PHY consists of three basic components: the Common block and Transceiver block.

- Common block: This block contains design components that can be reused for multiple transceivers.
- Transceiver block: This block contains the bulk of USB HOST 2.0 PHY circuitry for data processing and transfers.

25.5 Register description

25.5.1 Registers Summary

Name	Offset	Size	Reset Value	Description
HOST20_GOTGCTL	0x0000	W	0x00000000	Control and Status Register
HOST20_GOTGINT	0x0004	W	0x00000000	Interrupt Register
HOST20_GAHBCFG	0x0008	W	0x00000000	AHB Configuration Register
HOST20_GUSBCFG	0x000c	W	0x00001400	USB Configuration Register
HOST20_GRSTCTL	0x0010	W	0x80000000	Reset Register
HOST20_GINTSTS	0x0014	W	0x00000000	Interrupt Register
HOST20_GINTMSK	0x0018	W	0x00000000	Interrupt Mask Register

Name	Offset	Size	Reset Value	Description
HOST20_GRXSTSR	0x001c	W	0x00000000	Receive Status Debug Read
HOST20_GRXSTSP	0x0020	W	0x00000000	Receive Status Debug Pop
HOST20_GRXFSSIZ	0x0024	W	0x00000000	Receive FIFO Size Register
HOST20_GNPTXFSSIZ	0x0028	W	0x00000000	Non-Periodic Transmit FIFO Size Register
HOST20_GNPTXSTS	0x002c	W	0x00000000	Non-Periodic Transmit FIFO/Queue Status Register
HOST20_GI2CCTL	0x0030	W	0x11000000	I2C Address Register
HOST20_GPVNDCTL	0x0034	W	0x00000000	PHY Vendor Control Register
HOST20_GGPIO	0x0038	W	0x00000000	General Purpose Input/Output Register
HOST20_GUID	0x003c	W	0x00000000	User ID Register
HOST20_GSNPSID	0x0040	W	0x00004f54	Vendor ID Register
HOST20_GHWCFG1	0x0044	W	0x00000000	User HW Config1 Register
HOST20_GHWCFG2	0x0048	W	0x00000000	User HW Config2 Register
HOST20_GHWCFG3	0x004c	W	0x00000000	User HW Config3 Register
HOST20_GHWCFG4	0x0050	W	0x00000000	User HW Config4 Register
HOST20_GLPMCFG	0x0054	W	0x00000000	Core LPM Configuration Register
HOST20_GPWRDN	0x0058	W	0x00000000	Global Power Down Register
HOST20_GDFIFO CFG	0x005c	W	0x00000000	Global DFIFO Software Config Register
HOST20_GADPCTL	0x0060	W	0x00000000	ADP Timer, Control and Status Register
HOST20_HPTXFSSIZ	0x0100	W	0x00000000	Host Periodic Transmit FIFO Size Register
HOST20_DIEPTXFn	0x0104	W	0x00000000	Device Periodic Transmit FIFO-1 Size Register
HOST20_HCFG	0x0400	W	0x00000000	Host Configuration Register

Name	Offset	Size	Reset Value	Description
HOST20_HFIR	0x0404	W	0x00000000	Host Frame Interval Register
HOST20_HFNUM	0x0408	W	0x0000ffff	Host Frame Number/Frame Time Remaining Register
HOST20_HPTXSTS	0x0410	W	0x00000000	Host Periodic Transmit FIFO/Queue Status Register
HOST20_HAINT	0x0414	W	0x00000000	Host All Channels Interrupt Register
HOST20_HAINTMSK	0x0418	W	0x00000000	Host All Channels Interrupt Mask Register
HOST20_HPRT	0x0440	W	0x00000000	Host Port Control and Status Register
HOST20_HCCHARn	0x0500	W	0x00000000	Host Channel-n Characteristics Register
HOST20_HCSPLTn	0x0504	W	0x00000000	Host Channel-n Split Control Register
HOST20_HCINTn	0x0508	W	0x00000000	Host Channel-n Interrupt Register
HOST20_HCINTMSKn	0x050c	W	0x00000000	Host Channel-n Interrupt Mask Register
HOST20_HCTSIZn	0x0510	W	0x00000000	Host Channel-n Transfer Size Register
HOST20_HCDMAN	0x0514	W	0x00000000	Host Channel-n DMA Address Register
HOST20_HCDMABn	0x051c	W	0x00000000	Host Channel-n DMA Buffer Address Register
HOST20_DCFG	0x0800	W	0x08200000	Device Configuration Register
HOST20_DCTL	0x0804	W	0x00002000	Device Control Register
HOST20_DSTS	0x0808	W	0x00000000	Device Status Register
HOST20_DIEPMSK	0x0810	W	0x00000000	Device IN Endpoint common interrupt mask register
HOST20_DOEPMSK	0x0814	W	0x00000000	Device OUT Endpoint common interrupt mask register
HOST20_DAINT	0x0818	W	0x00000000	Device All Endpoints interrupt register

Name	Offset	Size	Reset Value	Description
HOST20_DAINTMSK	0x081c	W	0x00000000	Device All Endpoint interrupt mask register
HOST20_DTKNQR1	0x0820	W	0x00000000	Device IN token sequence learning queue read register1
HOST20_DTKNQR2	0x0824	W	0x00000000	Device IN token sequence learning queue read register2
HOST20_DVBUSDIS	0x0828	W	0x00000b8f	Device VBUS discharge time register
HOST20_DVBUSPULSE	0x082c	W	0x00000000	Device VBUS Pulsing Timer Register
HOST20_DTHRCTL	0x0830	W	0x08100020	Device Threshold Control Register
HOST20_DIEPEMPMSK	0x0834	W	0x00000000	Device IN endpoint FIFO empty interrupt mask register
HOST20_DEACHINT	0x0838	W	0x00000000	Device each endpoint interrupt register
HOST20_DEACHINTMSK	0x083c	W	0x00000000	Device each endpoint interrupt register mask
HOST20_DIEPEACHMSKn	0x0840	W	0x00000000	Device each IN endpoint -n interrupt Register
HOST20_DOEPEACHMSKn	0x0880	W	0x00000000	Device each out endpoint-n interrupt register
HOST20_DIEPCTL0	0x0900	W	0x00008000	Device control IN endpoint 0 control register
HOST20_DIEPINTn	0x0908	W	0x00000000	Device Endpoint-n Interrupt Register
HOST20_DIEPTSIZn	0x0910	W	0x00000000	Device endpoint n transfer size register
HOST20_DIEPDMAAn	0x0914	W	0x00000000	Device endpoint-n DMA address register
HOST20_DTXFSTSn	0x0918	W	0x00000000	Device IN endpoint transmit FIFO status register
HOST20_DIEPDMABn	0x091c	W	0x00000000	Device endpoint-n DMA buffer address register

Name	Offset	Size	Reset Value	Description
HOST20_DIEPCTLn	0x0920	W	0x00000000	Device endpoint-n control register
HOST20_DOEPCTL0	0x0b00	W	0x00000000	Device control OUT endpoint 0 control register
HOST20_DOEPINTn	0x0b08	W	0x00000000	Device endpoint-n control register
HOST20_DOEPTSIZn	0x0b10	W	0x00000000	Device endpoint n transfer size register
HOST20_DOEPDMAn	0x0b14	W	0x00000000	Device Endpoint-n DMA Address Register
HOST20_DOEPDMAFn	0x0b1c	W	0x00000000	Device endpoint-n DMA buffer address register
HOST20_DOEPCTLn	0x0b20	W	0x00000000	Device endpoint-n control register
HOST20_PCGCR	0x0b24	W	0x200b8000	Power and clock gating control register
HOST20_EPBUF0	0x1000	W	0x00000000	Device endpoint 0 / host out channel 0 address
HOST20_EPBUF1	0x2000	W	0x00000000	Device endpoint 1 / host out channel 1 address
HOST20_EPBUF2	0x3000	W	0x00000000	Device endpoint 2 / host out channel 2 address
HOST20_EPBUF3	0x4000	W	0x00000000	Device endpoint 3 / host out channel 3 address
HOST20_EPBUF4	0x5000	W	0x00000000	Device endpoint 4 / host out channel 4 address
HOST20_EPBUF5	0x6000	W	0x00000000	Device endpoint 5 / host out channel 5 address
HOST20_EPBUF6	0x7000	W	0x00000000	Device endpoint 6 / host out channel 6 address
HOST20_EPBUF7	0x8000	W	0x00000000	Device endpoint 7 / host out channel 7 address
HOST20_EPBUF8	0x9000	W	0x00000000	Device endpoint 8 / host out channel 8 address
HOST20_EPBUF9	0xa000	W	0x00000000	Device endpoint 9 / host out channel 9 address
HOST20_EPBUF10	0x9000	W	0x00000000	Device endpoint 10 / host out channel 10 address

Name	Offset	Size	Reset Value	Description
HOST20_EPBUF11	0xa000	W	0x00000000	Device endpoint 11 / host out channel 11 address
HOST20_EPBUF12	0x9000	W	0x00000000	Device endpoint 12 / host out channel 12 address
HOST20_EPBUF13	0xa000	W	0x00000000	Device endpoint 13 / host out channel 13 address
HOST20_EPBUF14	0x9000	W	0x00000000	Device endpoint 14 / host out channel 14 address
HOST20_EPBUF15	0xa000	W	0x00000000	Device endpoint 15 / host out channel 15 address

Notes:Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

25.5.2 Registers Description

Refer to 27.5.2

25.6 Interface description

Table 25- 1 USB HOST 2.0 Interface Description

Module Pin	Direction	Pad Name	pinmux
HOST_VSSAC	AG	HOST_VSSAC	-
HOST_DVSS	DG	HOST_DVSS	-
HOST_DVDD	DP	HOST_DVDD	-
HOST_VDD25	AP	HOST_VDD25	-
HOST_DM	A	HOST_DM	-
HOST_RKELVIN	A	HOST_RKELVIN	-
HOST_DP	A	HOST_DP	-
HOST_VSSA	AG	HOST_VSSA	-
HOST_VBUS	A	HOST_VBUS	-
HOST_VDD33	AP	HOST_VDD33	-
host_drv_vbus	O	GPIO0_A[6]	GRF_GPIO0A_IOMUX [12]=1

Note: **A**—Analog pad ; **AP**—Analog power; **AG**—Analog ground ;**DP**—Digital power ;**DG**—Digital ground;

Chapter 26 USB OTG2.0

26.1 Overview

USB OTG 2.0 is a Dual-Role Device controller, which supports both device and host functions and is fully compliant with OTG Supplement to USB2.0 specification, and support high-speed(480Mbps),full-speed(12Mbps),low-speed(1.5Mbps) transfer.

USB OTG 2.0 is optimized for portable electronic devices, point-to-point applications (no hub, direct connection to device) and multi-point applications to devices. USB OTG 2.0 interface supports both device and host functions and is fully compliant with OTG Supplement to USB2.0 specification, and support high-speed(480Mbps), full-speed(12Mbps), low-speed (1.5Mbps) transfer. It is optimized for portable electronic device , point-to-point applications (no hub, direct connection to device) and multi-point applications to devices.

26.1.1 Features

- Compliant with the OTG Supplement to the USB2.0 Specification
- Operates in High-Speed and Full-Speed mode
- Support Session Request Protocol(SRP) and Host Negotiation Protocol(HNP)
- Support 9 channels in host mode
- 9 Device mode endpoints in addition to control endpoint 0, 4 in, 3 out and 2 IN/OUT
- Built-in one 1024x35 bits FIFO
- Internal DMA with scatter/gather function
- Supports packet-based , dynamic FIFO memory allocation for endpoints for flexible, efficient use of RAM
- Provides support to change an endpoint's FIFO memory size during transfers

26.2 Block Diagram

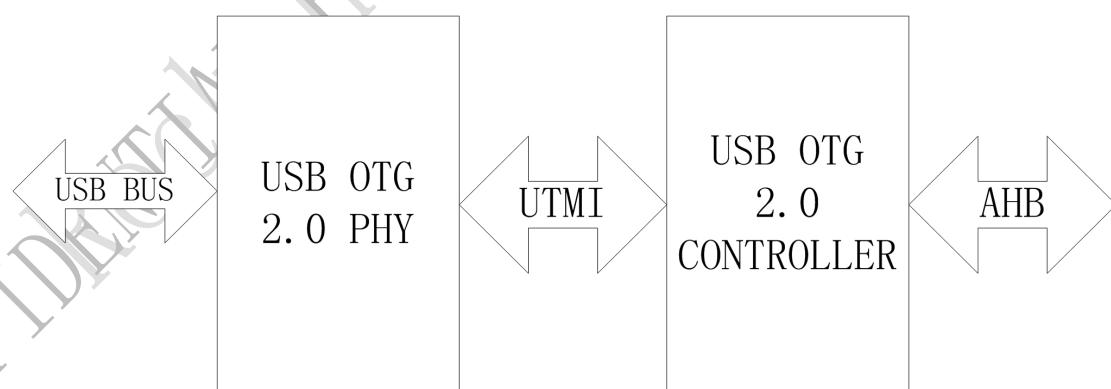


Fig. 26- 1USB OTG 2.0 Architecture

Fig.27-1 shows the architecture of USB OTG 2.0. It is broken up into two separate units: USB OTG 2.0 controller and USB OTG 2.0 PHY. The two units are interconnected with UTMI interface.

26.2.1 USB OTG 2.0 Controller Function

The USB OTG 2.0 Controller controls SIE(Serial Interface Engine) Logic , the Endpoint logic , the Channel logic and the internal DMA logic.

The SIE logic contains the USB PID and address recognition logic, and other sequencing and state machine logic to handle USB packets and transactions. Generally the SIE Logic is required for any USB implementation while the number and types of endpoints will vary as function of application and performance requirements.

The Endpoint Logic contains the endpoint specific logic: endpoint number recognition, FIFOs and FIFO control, etc.

The Channel Logic contains the channel tasks schedule, FIFOs and FIFO control, etc.

The internal DMA logic controls data transaction between system memory and USB FIFOs.

26.2.2 USB OTG 2.0 PHY Function

The USB OTG 2.0 PHY handles the low level USB protocol and signaling. This includes features such as; data serialization and deserialization, bit stuffing and clock recovery and synchronization. The primary focus of this block is to shift the clock domain of the data from the USB 2.0 rate to the frequency of UTMI clock which is 30MHz.

26.2.3 UTMI Interface

- Trasmit

Transmit must be asserted to enable any transmissions.

- 1) The USB OTG2.0 CONTROLLER asserts TXValid to begin a transmission and negates TXValid to end a transmission. After the USB OTG2.0 CONTROLLER asserts TXValid it can assume that the transmission has started when it detects TXReady asserted.
- 2) The USB OTG2.0 CONTROLLER assumes that the USB OTG2.0 PHY has consumed a data byte if TXReady and TXValid are asserted.
- 3) The USB OTG2.0 CONTROLLER must have valid packet information (PID) asserted on the DataIn bus coincident with the assertion of TXValid. Depending on the USB OTG2.0 PHY implementation, TXReady may be asserted by the Transmit State Machine as soon as one CLK after the assertion of TXValid.
- 4) TXValid and TXReady are sampled on the rising edge of CLK.
- 5) The Transmit State Machine does NOT automatically generate Packet ID's (PIPs) or CRC. When transmitting, the USB OTG2.0 CONTROLLER is always expected to present a PID as the first byte of the data stream and if appropriate , CRC as the last bytes of the data stream.
- 6) The USB OTG2.0 CONTROLLER must use LineState to verify a Bus Idle condition before asserting TXValid in the TX Waitstate.
- 7) The state of TXReady in the TX Wait and Send SYNC states is undefined. An MTU implementation may prepare for the next transmission immediately after the Send EOP state and assert TXReady in the TX Wait state. An MTU implementation may also assert TXReady in the Send SYNC state. The first assertion of TXReady is Macrocell implementation dependent. The USB OTG2.0 CONTROLLER must prepare DataIn for the first byte to be transmitted before asserting TXValid.

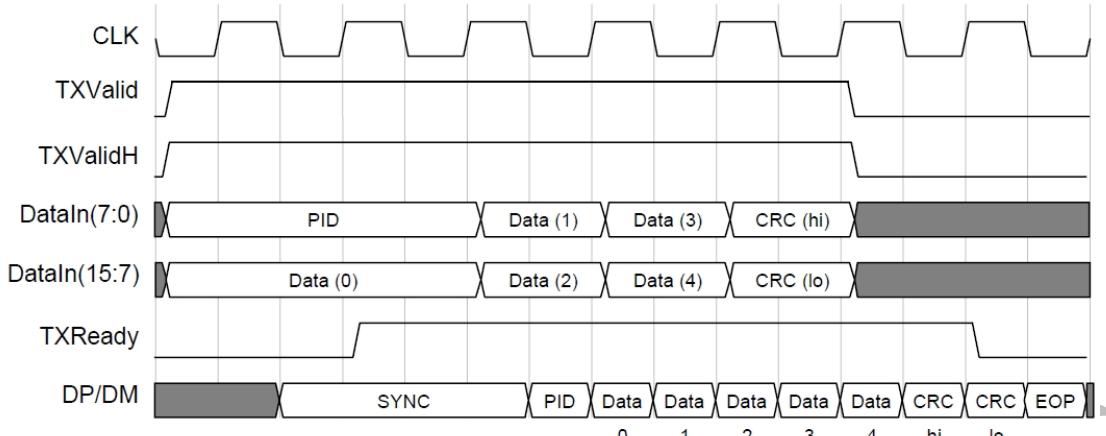


Fig. 26- 2 UTMI interface -Transmit timing for a data packet

- Receive

- 1) RXActive and RXValid are sampled on the rising edge of CLK.
- 2) In the RX Wait state the receiver is always looking for SYNC.
- 3) The USB OTG 2.0 PHY asserts RXActive when SYNC is detected (Strip SYNC state).
- 4) The USB OTG 2.0 PHY negates RXActive when an EOP is detected (Strip EOP state).
- 5) When RxActive is asserted, RXValid will be asserted if the RX Holding Register is full.
- 6) RXValid will be negated if the RX Holding Register was not loaded during the previous byte time.
- 7) This will occur if 8 stuffed bits have been accumulated.
- 8) The USB OTG2.0 Controller must be ready to consume a data byte if RXActive and RXValid are asserted (RX Data state).
- 9) In FS mode, if a bit stuff error is detected then the Receive State Machine will negate RXActive and
- 10) RXValid, and return to the RXWait state.

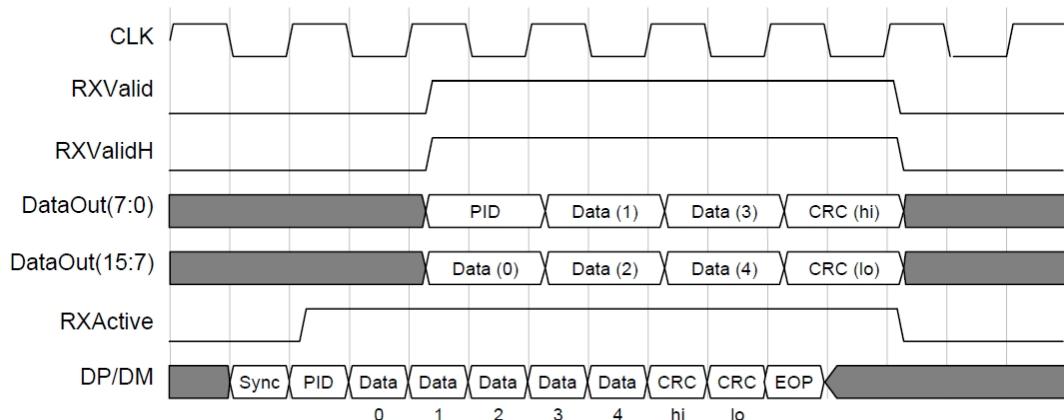


Fig. 26- 3 UTMI interface – Receive timing for a data packet

26.3 USB OTG2.0 Controller

USB OTG Controller is a Dual-Role Device controller, which supports both device and host functions and is fully compliant with OTG Supplement to USB2.0 specification, and support high-speed(480Mbps), full-speed(12Mbps), low-speed (1.5Mbps) transfer. This controller will support UTMI+ Level 3 PHY interface. It connects to the industry-standard AMBA AHB for communication with the application and system memory. And it is optimized for portable

electronic device , point-to-point applications (no hub, direct connection to device) and multi-point applications to devices.

Fig.27-2 shows the main components and flow of the USB OTG 2.0 controller system.

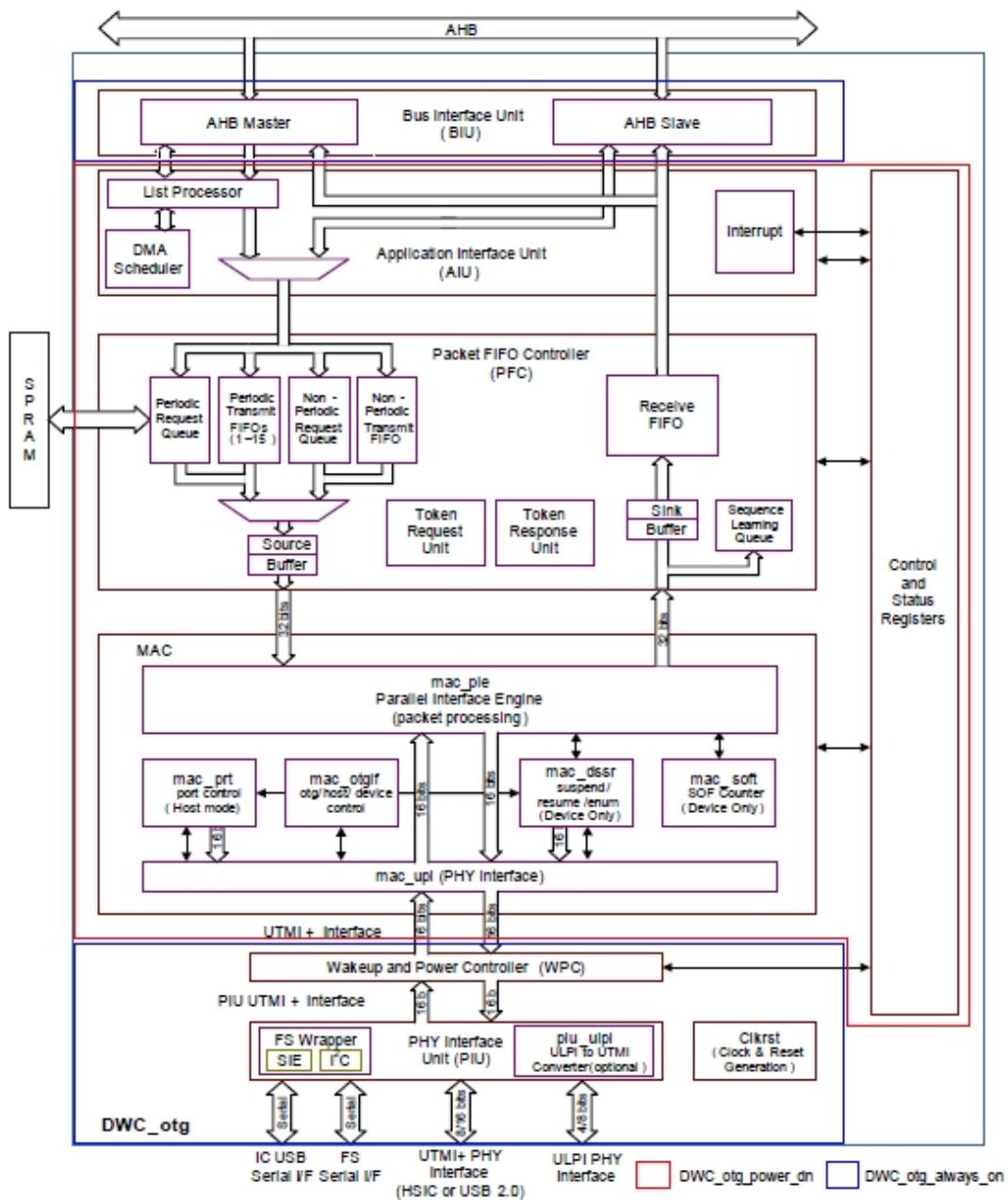


Fig. 26- 4 USB OTG2.0 Controller Architecture

26.3.1 Host Architercture

The host uses one transmit FIFO for all non-periodic OUT transactions and one transmit FIFO for all periodic OUT transactions (periodic FIFOs 2 to n are only used in Device mode, where n is number of periodic IN endpoints in Device mode). These transmit FIFOs are used as transmit buffers to hold the data (payload of the transmit packet) to be transmitted over USB. The host pipes the USB transactions through Request queues (one for periodic and one for non-periodic). Each entry in the Request queue holds the IN or OUT channel number along with other information to perform a transaction on the USB. The order in which the requests are written into the queue determines the sequence

of transactions on the USB. The host processes the periodic Request queue first, followed by the non-periodic Request queue, at the beginning of each (micro)frame. The host uses one receive FIFO for all periodic and non-periodic transactions. The FIFO is used as a receive buffer to hold the received data (payload of the received packet) from the USB until it is transferred to the system memory. The status of each packet received also goes into the FIFO. The status entry holds the IN channel number along with other information, such as received byte count and validity status, to perform a transaction on the AHB. Fig27-2 shows the bus interface architecture of the USB OTG 2.0 Controller in Host mode.

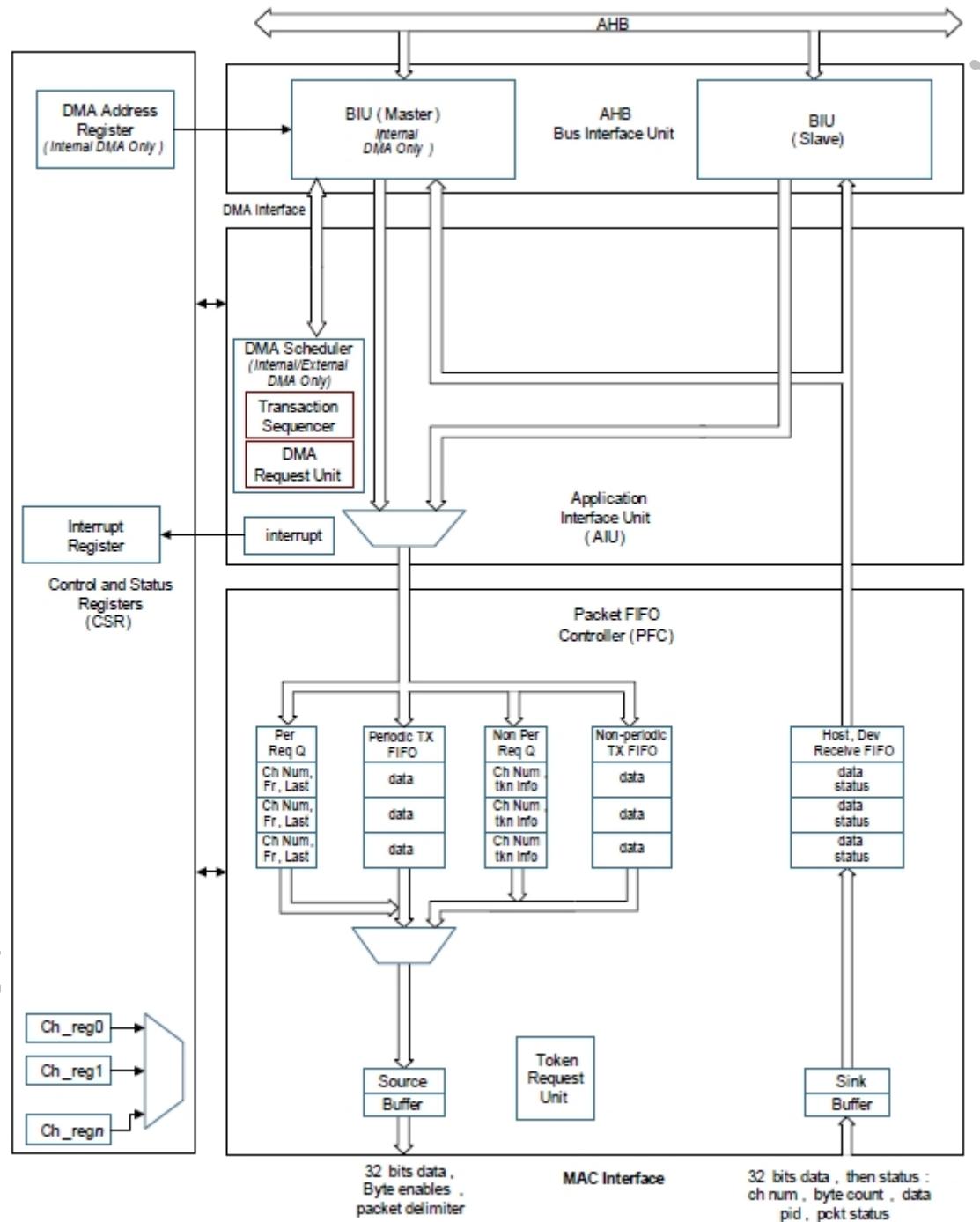


Fig. 26-5 USB OTG2.0 Controller – Host Architecture

26.3.2 Device Architecture

- Dedicated Transmit FIFO Operation

When dedicated transmit FIFO architecture is used (`OTG_EN_DED_TX_FIFO = 1`), the core uses individual transmit FIFOs for each IN endpoint. There are no Request queues associated with any of the FIFOs. There is no need for the application to predict the order in which the USB host is going to access the non-periodic endpoints. In Dedicated Transmit FIFO Operation, the core also supports thresholding in the transmit and receive directions when DMA mode is selected. For Transmit mode there are separate controls to enable thresholding for isochRnous and non-isochRnous transfers. When thresholding is enabled, the core can be configured to have less-than-one-packet-sized FIFO. The core internally handles underrun condition during transmit and corrupts the packet (inverts the CRC) on the USB. During receive with thresholding, when a packet ends up in a FIFO overflow condition, the core NAKs the OUT packet and internally rewinds the pointers. When thresholding is enabled, vendor recommends that you have a FIFO size two times the threshold value. If packet transmission results in underrun condition—(eventually resulting in packet corruption on the USB—often the host can time out the endpoint after three consecutive errors.

- Single Receive FIFO

The OTG device uses a single receive FIFO to receive the data for all the OUT endpoints. The receive FIFO holds the status of the received data packet, such as byte count, data PID and the validity of the received data. The DMA or the application reads the data out of the receive FIFO as it is received.

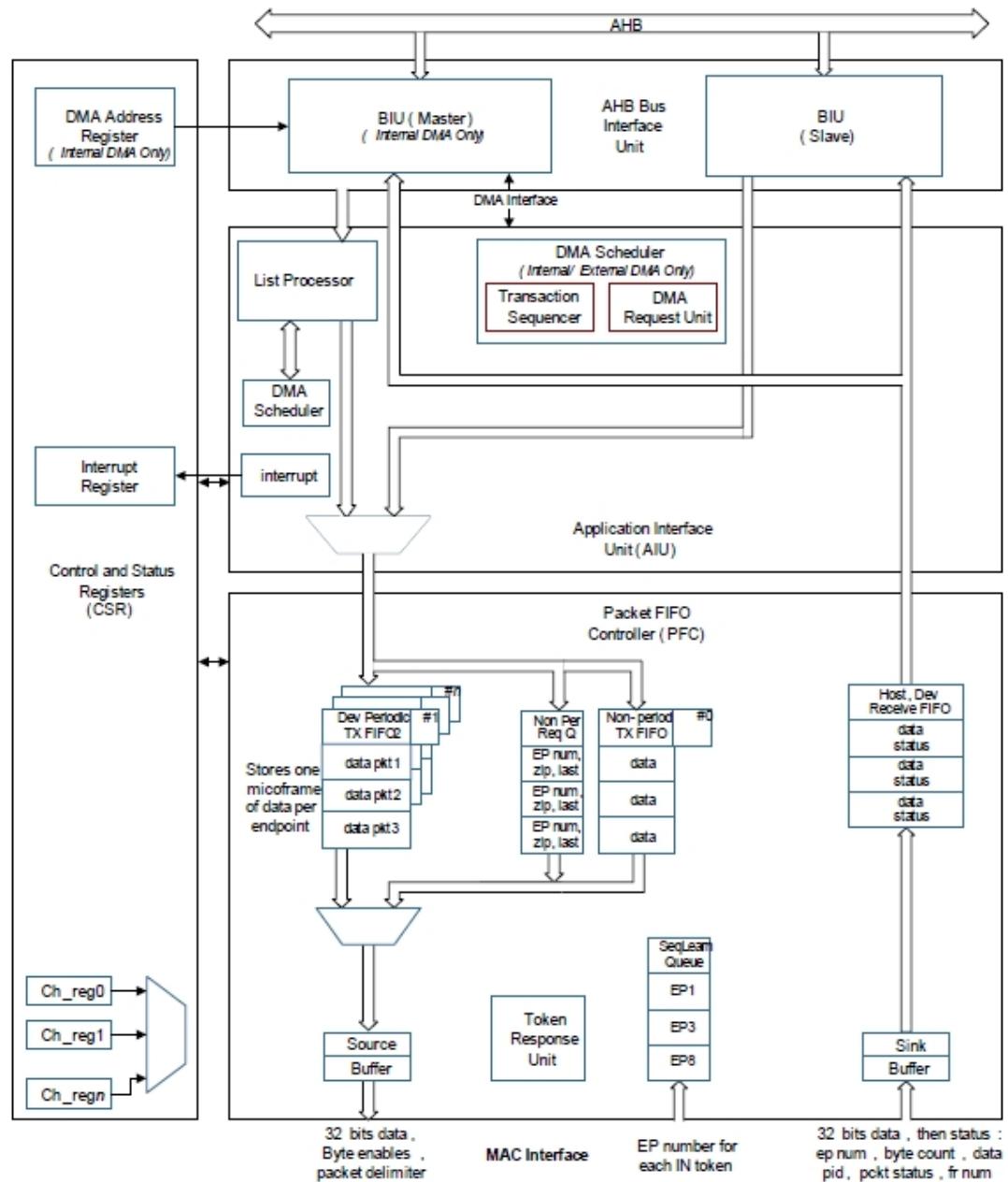


Fig. 26-6 USB OTG2.0 Controller – Host Architecture

26.3.3 Internal DMA Mode

Internal DMA mode is typically selected when the CPU bandwidth to process the USB transfer is limited and you would like an internal DMA controller to take care of the data transfers between the system memory and the USB OTG 2.0 Controller. The driver sets up the transfer and the USB OTG 2.0 Controller interrupts the processor only on transfer completion or an error condition.

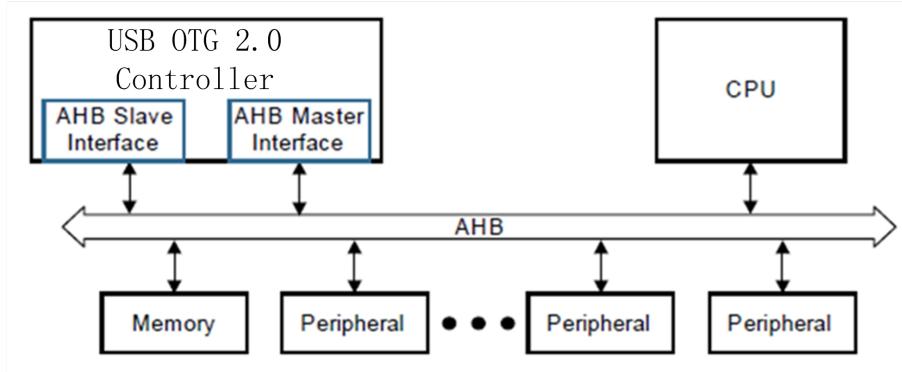


Fig. 26-7 USB OTG2.0 Controller – Internal DMA mode

26.3.4 FIFO Mapping

- Fig.27-8 shows FIFO mapping in Host mode.
When the device is operating in Internal DMA mode, the last locations of the SPRAM are used to store the DMAADDR values for each channel.

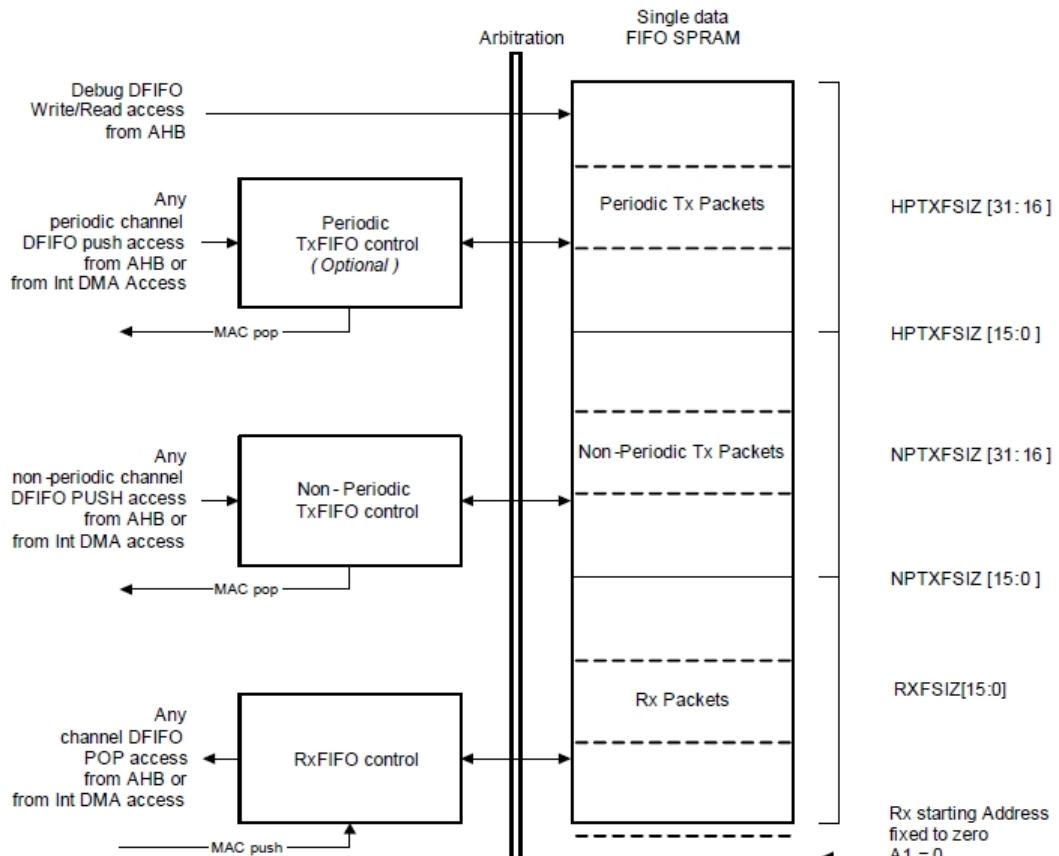


Fig. 26-8 USB OTG 2.0 Controller host mode FIFO address mapping

- Fig.27-9 shows FIFO mapping in Device mode.

When the device is operating in non Descriptor Internal DMA mode, the last locations of the SPRAM are used to store the DMAADDR values for each channel. When the device is operating in Descriptor mode, then the last locations of the SPRAM store the Base Descriptor address, Current Descriptor address, Current Buffer address, and status quadlet information for each endpoint direction.

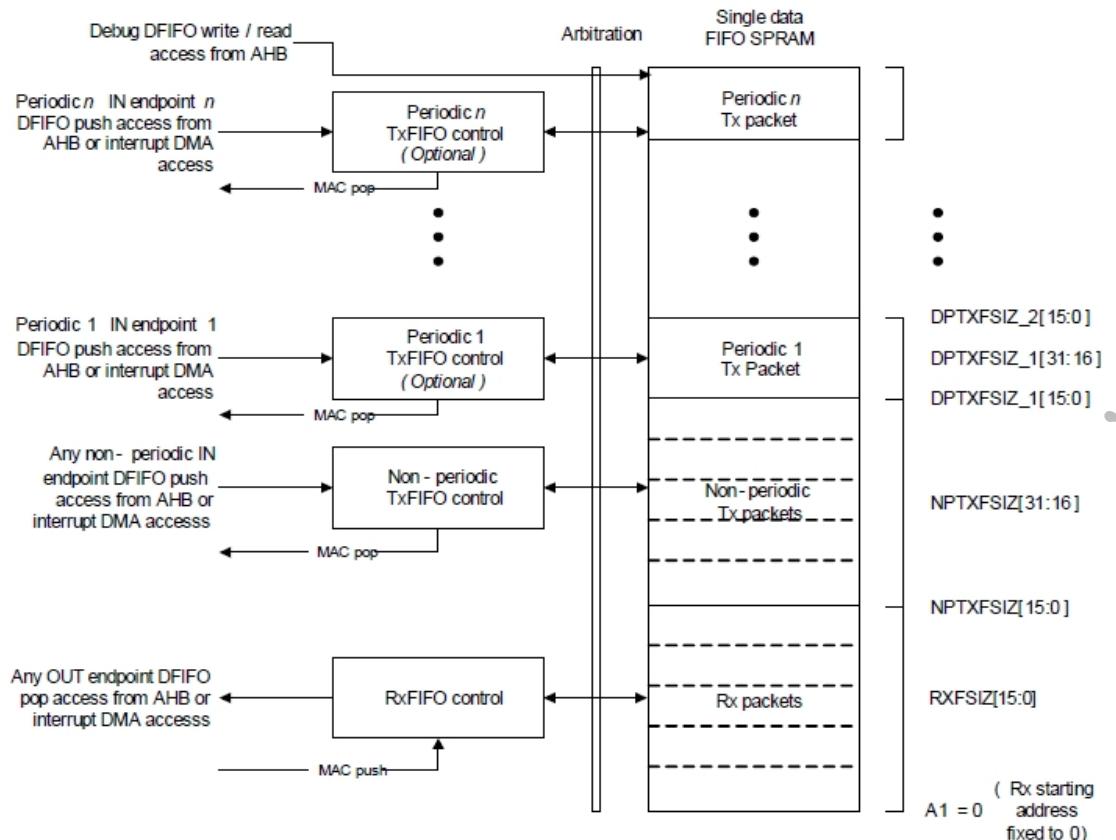


Fig. 26- 9 USB OTG 2.0 Controller device mode FIFO address mapping

26.3.5 Sub-Module Architecture

1.DMA Scheduler (DSCH)

This block is used only in DMA mode. It controls the transfer of data packets between the system memory and the USB OTG 2.0 Controller for both Internal and External DMA. The following functions constitute the DMA scheduler:

- Arbiter

This logic provides the sequence in which the channels/endpoints are to be processed in DMA mode. In Host mode, the arbiter provides Round-Rbin arbitration among periodic and non-periodic channels. Periodic channels are processed with higher priority. In Device mode with Shared FIFO operation (OTG_ENDED_TX_FIFO = 0), the arbiter provides a Round-Rbin arbitration only among periodic endpoints. Arbitration for non-periodic endpoints is based on Next EP Number1 link register values. Periodic endpoints are processed with higher priority. In Device mode, during a Dedicated Transmit FIFO operation (OTG_ENDED_TX_FIFO = 1), and when threshold is enabled, the priority is as follows:

- a) Any transmit endpoint which is active on the USB.
- b) Any receive data in a receive FIFO.
- c) Round-Rbin arbitration on periodic transmit endpoints.
- d) Round-Rbin arbitration on non-periodic transmit endpoints.

In device mode when dedicated FIFO mode is used and when thresholding is not enabled, Round Rbin arbitration is used for periodic and non-periodic IN endpoints with priority given to periodic IN endpoints.

- DMA Request State Machine The state machine is responsible for the following:

- Requesting the External/Internal DMA for data fetch (from system memory to transmit FIFO, one maximum packet size or last packet size at a time)
- Writing the OUT request token into the request queue at the end of data fetch, in host mode and in Device mode when OTG_ENDED_TX_FIFO = 0.
- Writing the IN request token into the Request Queue in Host mode
- Requesting the External/Internal DMA for data update (from receive FIFO to system memory, one maximum packet size or last packet size at a time)
- Writing the Request Queue for ping, complete split, zero-length packet, or disable channel requests for the host.

2. Packet FIFO Controller (PFC)

Fig.27-10 represents the Packet FIFO Controller in Shared FIFO operation. Several FIFOs are used in Device and Host modes to store data inside the core before transmitting it on either the AHB or the USB.

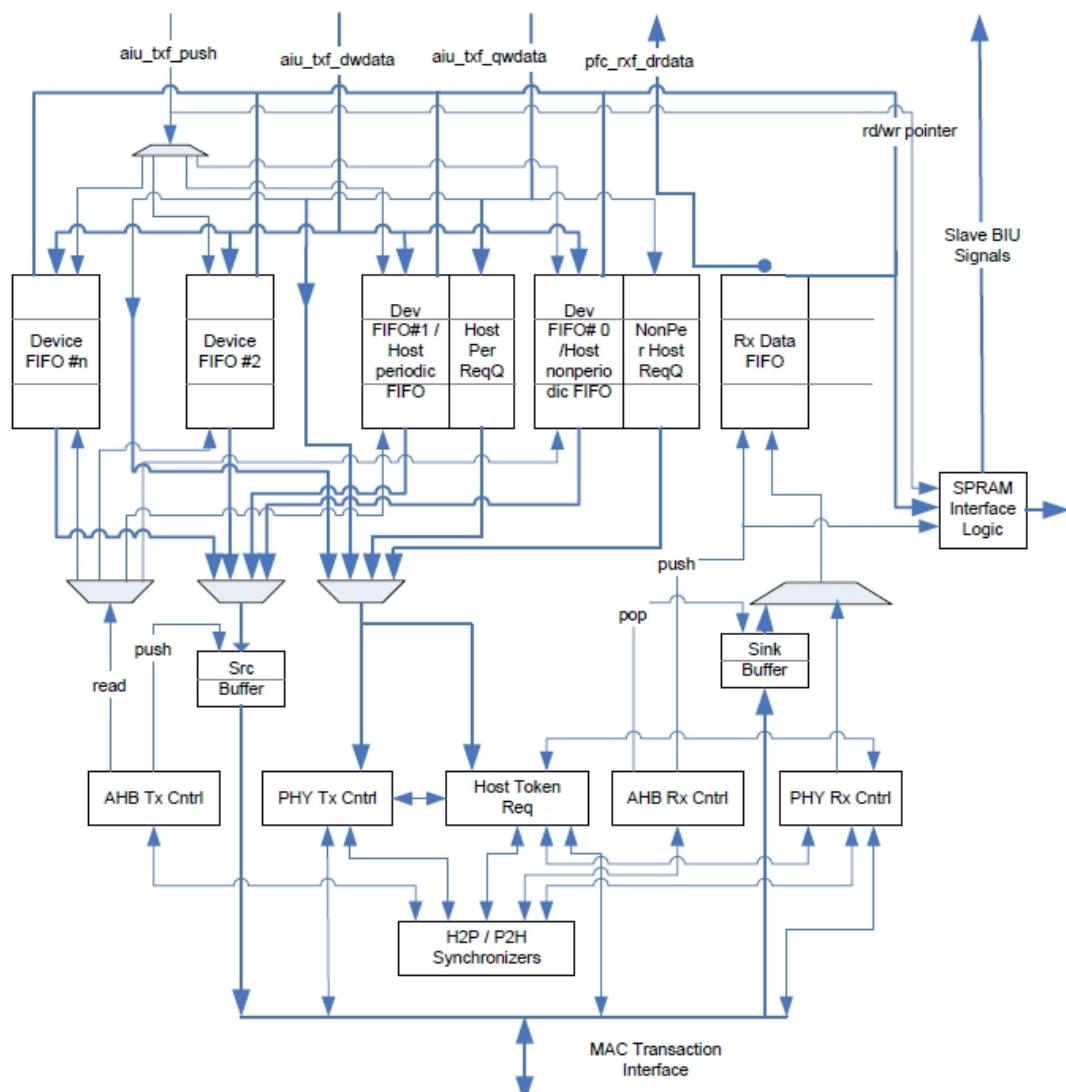


Fig. 26- 10 USB OTG 2.0 Controller Packet FIFO controller

- PFC-to-SPRAM interface

Fig.27-11 shows how to connect the USB OTG 2.0 Controller Data FIFO

interface to an industry-standard, single-port synchronous SRAM. Address, write data, and control outputs are driven late by the USB OTG 2.0 Controller, but in time to meet the SRAM setup requirements. Input read data is expected late from the SRAM and registered inside the core before being used.

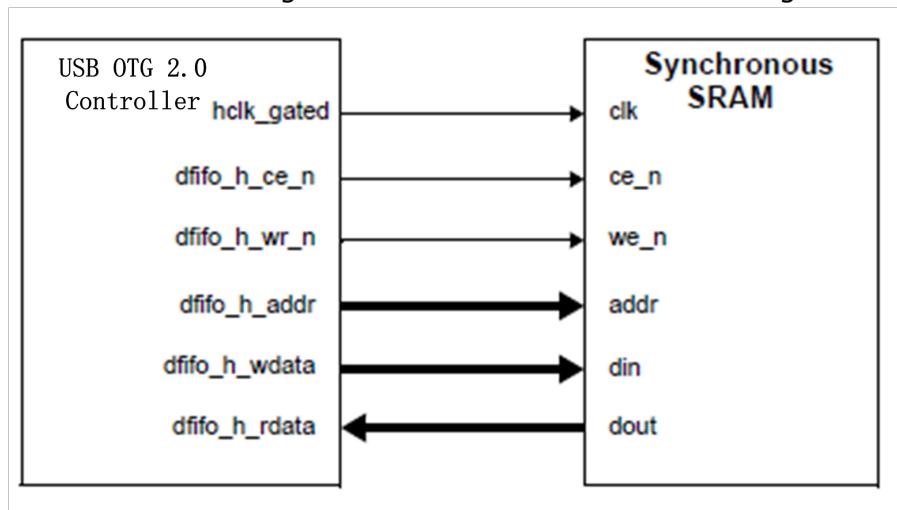


Fig. 26- 11 DFIFO single-port synchronous SRAM interface

3. Media Access Controller

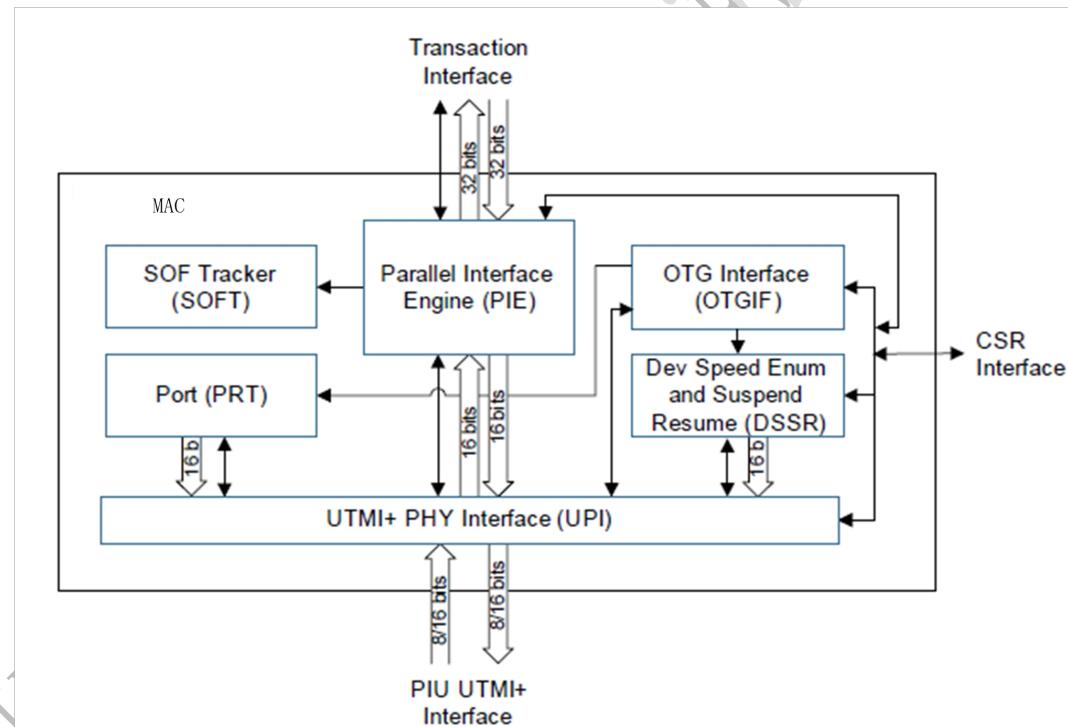


Fig. 26- 12 USB OTG 2.0 Controller – MAC block diagram

Fig 27-12 shows the major MAC module components.

The major blocks are:

- Device Speed enumeration, Suspend, and Resume block (DSSR) The DSSR block is only active in Device mode. This block performs the speed enumeration, suspend, resume and remote wakeup functions in Device mode.
- Parallel Interface Engine (PIE) This block is responsible for token, data, and handshake packet generation and reception, and PID and CRC checking and generation. It generates handshake and data packets based on data

integrity and on CSR control and FIFO status information. The PIE also handles the data transfer to and from the FIFO, and the status update to the PFC and AIU.

- SOF tracker (SOFT) This block tracks SOF packets and generates SOF interrupts in Device mode. It handles missing SOFs and delayed SOFs to keep the frame number synchronization between the host and the device.
- Port (PRT) The Port block is only active in the Host mode. It is responsible for connect and disconnect detection, USB reset and speed enumeration, suspend and resume generation, remote wakeup detection, SOF generation, and High Speed Test mode handling. OTG Interface (OTGIF) The OTG Interface block handles SRP and HNP. These OTG protocols are implemented either through the regular UTMI+ interface
- UTMI+ PHY Interface (UPI) The block converts data widths for the 8-bit PHY interface and multiplexes output signals to the PHY from multiple blocks. It also implements some logic shared by multiple MAC blocks. The MAC is designed so that unused components can be removed in some configurations to reduce gate count. SOFT, DSSR, and OTGIF can be removed in a host-only configuration; PRT and OTGIF can be removed for device-only configuration.

26.4 USB OTG2.0 PHY

The USB OTG 2.0 PHY connects a USB OTG controller to a USB system. It is a complete mixed-signal IP designed to implement OTG connectivity in a System-on-Chip(SOC) design targeted to a specific fabrication process using core and 2.5-V thick-oxide devices. The USB 2.0 PHY supports the USB2.0 480-Mbps protocol and data rate, and is backward compatible with the USB 1.1 1.5-Mbps and 12-Mbps protocol and data rates.

26.4.1 Block Diagram

Fig.27-13 shows the USB OTG 2.0 PHY functional block diagram for a one-port macro.

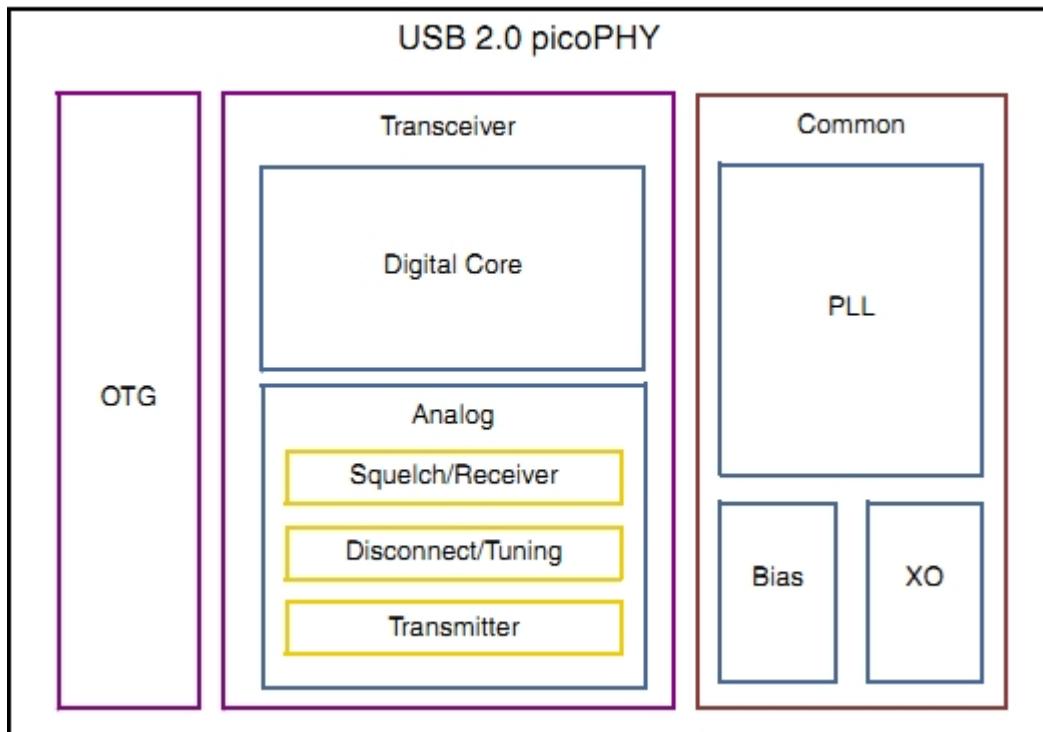


Fig. 26-13 USB OTG 2.0 PHY Architecture

The USB OTG 2.0 PHY consists of three basic components: the Common block, Transceiver block, and OTG block.

- Common block: This block contains design components that can be reused for multiple transceivers.
- Transceiver block: This block contains the bulk of USB OTG 2.0 PHY circuitry for data processing and transfers.
- OTG block: This block enables A-devices and B-devices to initiate the Session Request Protocol (SRP), and dual-Role devices to initiate the Host Negotiation Protocol (HNP).

26.4.2 Powering Up and Powering Down

- Powering UP

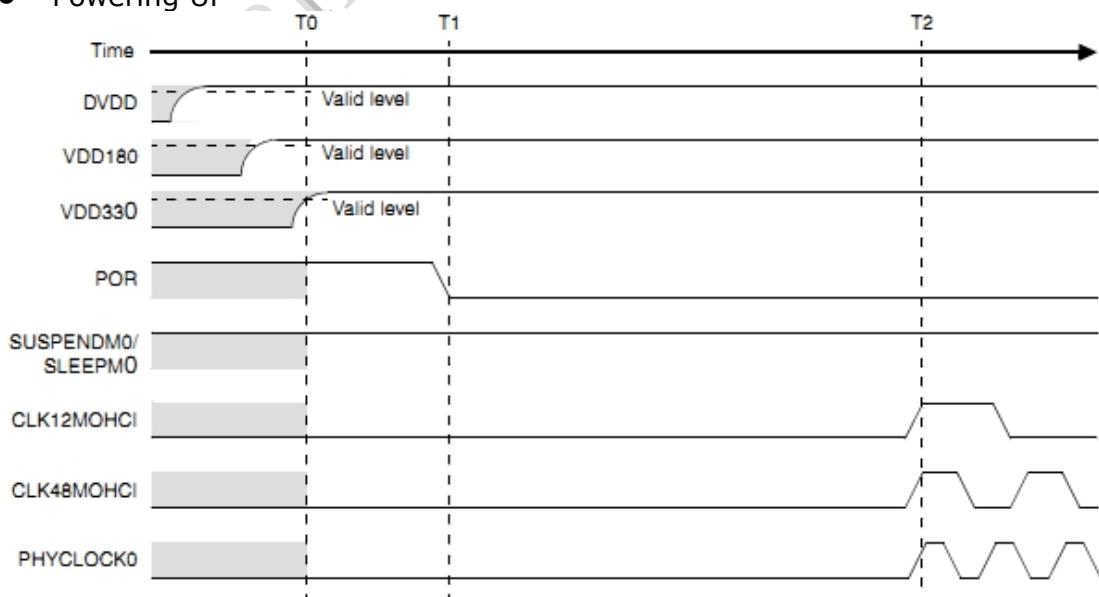


Fig. 26-14 USB OTG 2.0 PHY power supply and power up sequence

Table 26- 1 USB OTG 2.0 PHY power supply timing parameter

Timing Parameter	Description	Value
T0	Power-on reset (POR) is initiated.	0 (reference)
T1	T1 indicates when POR can be set to 1'b0. (To provide examples, values for T2 and T3 are also shown where $T1 = T0 + 30 \mu s$.) In general, T1 must be $\geq T0 + 10 \mu s$.	$T0 + 10 \mu s \leq T1$
T2	T2 indicates when PHYCLOCK0, CLK48MOHCl, and CLK12MOHCl are available at the macro output, based on the USB 2.0 picoPHY reference clock source.	<p>Crystal:</p> <ul style="list-style-type: none"> ▪ When $T1 = T0 + 10 \mu s$: $T2 < T1 + 805 \mu s = T0 + 815 \mu s$ ▪ When $T1 = T0 + 30 \mu s$: $T2 < T1 + 805 \mu s = T0 + 835 \mu s$ <p>External board clock or CLKCORE:</p> <ul style="list-style-type: none"> ▪ When $T1 = T0 + 10 \mu s$: $T2 < T1 + 45 \mu s = T0 + 55 \mu s$ ▪ When $T1 = T0 + 30 \mu s$: $T2 < T1 + 45 \mu s = T0 + 75 \mu s$

26.4.3 Removing Power Supplies for Power Saving

There is no requirement on the power-down sequence for the USB groups. Customers can decide which voltage to be down first based on the application, it is recommended to keep the time between collapsing of power supplies as short as possible

26.5 Register description

26.5.1 Register Summary

Name	Offset	Size	Reset Value	Description
USBOTG_GOTGCTL	0x0000	W	0x00000000	Control and Status Register
USBOTG_GOTGINT	0x0004	W	0x00000000	Interrupt Register
USBOTG_GAHBCFG	0x0008	W	0x00000000	AHB Configuration Register
USBOTG_GUSBCFG	0x000c	W	0x00001400	USB Configuration Register
USBOTG_GRSTCTL	0x0010	W	0x80000000	Reset Register
USBOTG_GINTSTS	0x0014	W	0x00000000	Interrupt Register
USBOTG_GINTMSK	0x0018	W	0x00000000	Interrupt Mask Register
USBOTG_GRXSTSR	0x001c	W	0x00000000	Receive Status Debug Read
USBOTG_GRXSTSP	0x0020	W	0x00000000	Receive Status Read and Pop
USBOTG_GRXFSIZ	0x0024	W	0x00000000	Receive FIFO Size Register
USBOTG_GNPTXFSIZ	0x0028	W	0x00000000	Non-Periodic Transmit FIFO Size Register
USBOTG_GNPTXSTS	0x002c	W	0x00000000	Non-Periodic Transmit FIFO/Queue Status Register
USBOTG_GI2CCTL	0x0030	W	0x11000000	I2C Address Register

Name	Offset	Size	Reset Value	Description
USBOTG_GPVNDCTL	0x0034	W	0x00000000	PHY Vendor Control Register
USBOTG_GGPIO	0x0038	W	0x00000000	General Purpose Input/Output Register
USBOTG_GUID	0x003c	W	0x00000000	User ID Register
USBOTG_GSNPSID	0x0040	W	0x00004f54	Core ID Register
USBOTG_GHWCFG1	0x0044	W	0x00000000	User HW Config1 Register
USBOTG_GHWCFG2	0x0048	W	0x00000000	User HW Config2 Register
USBOTG_GHWCFG3	0x004c	W	0x00000000	User HW Config3 Register
USBOTG_GHWCFG4	0x0050	W	0x00000000	User HW Config4 Register
USBOTG_GLPMCFG	0x0054	W	0x00000000	Core LPM Configuration Register
USBOTG_GPWRDN	0x0058	W	0x00000000	Global Power Down Register
USBOTG_GDFIFO CFG	0x005c	W	0x00000000	Global DFIFO Software Config Register
USBOTG_GADPCTL	0x0060	W	0x00000000	ADP Timer, Control and Status Register
USBOTG_HPTXFSIZ	0x0100	W	0x00000000	Host Periodic Transmit FIFO Size Register
USBOTG_DIEPTXFn	0x0104	W	0x00000000	Device Periodic Transmit FIFO-n Size Register
USBOTG_HCFG	0x0400	W	0x00000000	Host Configuration Register
USBOTG_HFIR	0x0404	W	0x00000000	Host Frame Interval Register
USBOTG_HFNUM	0x0408	W	0x0000ffff	Host Frame Number/Frame Time Remaining Register
USBOTG_HPTXSTS	0x0410	W	0x00000000	Host Periodic Transmit FIFO/Queue Status Register
USBOTG_HAINT	0x0414	W	0x00000000	Host All Channels Interrupt Register
USBOTG_HAI NTMSK	0x0418	W	0x00000000	Host All Channels Interrupt Mask Register
USBOTG_HPRT	0x0440	W	0x00000000	Host Port Control and Status Register
USBOTG_HCCHARn	0x0500	W	0x00000000	Host Channel-n Characteristics Register
USBOTG_HCSPLTn	0x0504	W	0x00000000	Host Channel-n Split Control Register
USBOTG_HCINTn	0x0508	W	0x00000000	Host Channel-n Interrupt Register
USBOTG_HCINTMSKn	0x050c	W	0x00000000	Host Channel-n Interrupt Mask Register

Name	Offset	Size	Reset Value	Description
USBOTG_HCTSIZn	0x0510	W	0x00000000	Host Channel-n Transfer Size Register
USBOTG_HCDMAN	0x0514	W	0x00000000	Host Channel-n DMA Address Register
USBOTG_HCDMABn	0x051c	W	0x00000000	Host Channel-n DMA Buffer Address Register
USBOTG_DCFG	0x0800	W	0x08200000	Device Configuration Register
USBOTG_DCTL	0x0804	W	0x00002000	Device Control Register
USBOTG_DSTS	0x0808	W	0x00000000	Device Status Register
USBOTG_DIEPMSK	0x0810	W	0x00000000	Device IN Endpoint common interrupt mask register
USBOTG_DOEPMISK	0x0814	W	0x00000000	Device OUT Endpoint common interrupt mask register
USBOTG_DAINT	0x0818	W	0x00000000	Device All Endpoints interrupt register
USBOTG_DAINTMSK	0x081c	W	0x00000000	Device All Endpoint interrupt mask register
USBOTG_DTKNQR1	0x0820	W	0x00000000	Device IN token sequence learning queue read register1
USBOTG_DTKNQR2	0x0824	W	0x00000000	Device IN token sequence learning queue read register2
USBOTG_DVBUSDIS	0x0828	W	0x00000b8f	Device VBUS discharge time register
USBOTG_DVBUSPULSE	0x082c	W	0x00000000	Device VBUS Pulsing Timer Register
USBOTG_DTHRCTL	0x0830	W	0x08100020	Device Threshold Control Register
USBOTG_DIEPEMPMSK	0x0834	W	0x00000000	Device IN endpoint FIFO empty interrupt mask register
USBOTG_DEACHINT	0x0838	W	0x00000000	Device each endpoint interrupt register
USBOTG_DEACHINTMSK	0x083c	W	0x00000000	Device each endpoint interrupt register mask
USBOTG_DIEPEACHMSKn	0x0840	W	0x00000000	Device each IN endpoint -n interrupt Register
USBOTG_DOEPEACHMSKn	0x0880	W	0x00000000	Device each out endpoint-n interrupt register
USBOTG_DIEPCTL0	0x0900	W	0x00008000	Device control IN endpoint 0 control register
USBOTG_DIEPINTn	0x0908	W	0x00000000	Device Endpoint-n Interrupt Register
USBOTG_DIEPTTSIZn	0x0910	W	0x00000000	Device endpoint n transfer size register

Name	Offset	Size	Reset Value	Description
USBOTG_DIEPDMA _n	0x0914	W	0x00000000	Device endpoint-n DMA address register
USBOTG_DTXFSTS _n	0x0918	W	0x00000000	Device IN endpoint transmit FIFO status register
USBOTG_DIEPDMA _{Bn}	0x091c	W	0x00000000	Device endpoint-n DMA buffer address register
USBOTG_DIEPCTL _n	0x0920	W	0x00000000	Device endpoint-n control register
USBOTG_DOEPCTL0	0x0b00	W	0x00000000	Device control OUT endpoint 0 control register
USBOTG_DOEPINT _n	0x0b08	W	0x00000000	Device endpoint-n control register
USBOTG_DOEPTSIZ _n	0x0b10	W	0x00000000	Device endpoint n transfer size register
USBOTG_DOEPDMA _n	0x0b14	W	0x00000000	Device Endpoint-n DMA Address Register
USBOTG_DOEPDMA _{Bn}	0x0b1c	W	0x00000000	Device endpoint-n DMA buffer address register
USBOTG_DOEPCTL _n	0x0b20	W	0x00000000	Device endpoint-n control register
USBOTG_PCGCR	0x0b24	W	0x200b8000	Power and clock gating control register
USBOTG_EPBUFO	0x1000	W	0x00000000	Device endpoint 0 / host out channel 0 address
USBOTG_EPBUF1	0x2000	W	0x00000000	Device endpoint 1 / host out channel 1 address
USBOTG_EPBUF2	0x3000	W	0x00000000	Device endpoint 2 / host out channel 2 address
USBOTG_EPBUF3	0x4000	W	0x00000000	Device endpoint 3 / host out channel 3 address
USBOTG_EPBUF4	0x5000	W	0x00000000	Device endpoint 4 / host out channel 4 address
USBOTG_EPBUF5	0x6000	W	0x00000000	Device endpoint 5 / host out channel 5 address
USBOTG_EPBUF6	0x7000	W	0x00000000	Device endpoint 6 / host out channel 6 address
USBOTG_EPBUF7	0x8000	W	0x00000000	Device endpoint 7 / host out channel 7 address

Notes: **Size:** **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

26.5.2 Detail Register Description

USBOTG_GOTGCTL

Address: Operational Base + offset (0x0000)
Control and Status Register

Bit	Attr	Reset Value	Description
31:28	RO	0x0	reserved

Bit	Attr	Reset Value	Description
27	RW	0x0	<p>ChirpEn Chirp on enable</p> <p>This bit when programmed to 1'b1 results in the core asserting chirp_on before sending an actual Chirp "K" signal on USB. This bit is present only if OTG_BC_SUPPORT = 1. If OTG_BC_SUPPORT != 1, this bit is a reserved bit.</p>
26:22	RO	0x00	<p>MultValidBc Multi Valued ID pin</p> <p>Battery Charger ACA inputs in the following order:</p> <ul style="list-style-type: none"> Bit 26 - rid_float. Bit 25 - rid_gnd Bit 24 - rid_a Bit 23 - rid_b Bit 22 - rid_c <p>These bits are present only if OTG_BC_SUPPORT = 1. Otherwise, these bits are reserved and will read 5'h0.</p>
21	RO	0x0	reserved
20	RW	0x0	<p>OTGVer OTG version</p> <p>Indicates the OTG revision.</p> <p>0: OTG Version 1.3. In this version the core supports Data line pulsing and VBus pulsing for SRP.</p> <p>1: OTG Version 2.0. In this version the core supports only Data line pulsing for SRP.</p>
19	RO	0x0	<p>BSesVld B-session valid</p> <p>Indicates the Device mode transceiver status.</p> <p>0: B-session is not valid.</p> <p>1: B-session is valid.</p> <p>In OTG mode, you can use this bit to determine if the device is connected or disconnected.</p> <p>Note: If you do not enable OTG features (such as SRP and HNP), the read reset value will be 1. The vbus assigns the values internally for non-SRP or non-HNP configurations.</p>

Bit	Attr	Reset Value	Description
18	RO	0x0	<p>ASesVld A-session valid Indicates the Host mode transceiver status. 0: A-session is not valid 1: A-session is valid Note: If you do not enable OTG features (such as SRP and HNP), the read reset value will be 1. The vbus assigns the values internally for non-SRP or non-HNP configurations.</p>
17	RO	0x0	<p>DbnTime Long/short debounce time Indicates the debounce time of a detected connection. 0: Long debounce time, used for physical connections (100 ms + 2.5 us) 1: Short debounce time, used for soft connections (2.5 us)</p>
16	RO	0x0	<p>ConIDSts Connector ID Status Indicates the connector ID status on a connect event. 0: The core is in A-Device mode 1: The core is in B-Device mode</p>
15:12	RO	0x0	reserved
11	RW	0x0	<p>DevHNPEn Device HNP Enable The application sets this bit when it successfully receives a SetFeature. SetHNPEnable command from the connected USB host. 0: HNP is not enabled in the application 1: HNP is enabled in the application</p>
10	RW	0x0	<p>HstSetHNPEn Host set HNP enable The application sets this bit when it has successfully enabled HNP (using the SetFeature. SetHNPEnable command) on the connected device. 0: Host Set HNP is not enabled 1: Host Set HNP is enabled</p>

Bit	Attr	Reset Value	Description
9	RW	0x0	<p>HNPRq HNP request</p> <p>The application sets this bit to initiate an HNP request to the connected USB host. The application can clear this bit by writing a 0 when the Host Negotiation Success Status Change bit in the OTG Interrupt register (GOTGINT.HstNegSucStsChng) is set. The core clears this bit when the HstNegSucStsChng bit is cleared.</p> <p>0: No HNP request 1: HNP request</p>
8	RO	0x0	<p>HstNegScs Host Negotiation Success</p> <p>The core sets this bit when host negotiation is successful. The core clears this bit when the HNP Request (HNPRq) bit in this register is set.</p> <p>0: Host negotiation failure 1: Host negotiation success</p>
7:2	RO	0x0	reserved
1	RW	0x0	<p>SesReq Session Request</p> <p>The application sets this bit to initiate a session request on the USB. The application can clear this bit by writing a 0 when the Host Negotiation Success Status Change bit in the OTG Interrupt register (GOTGINT.HstNegSucStsChng) is set. The core clears this bit when the HstNegSucStsChng bit is cleared. If you use the USB 1.1 Full-Speed Serial Transceiver interface to initiate the session request, the application must wait until the VBUS discharges to 0.2 V, after the B-Session Valid bit in this register (GOTGCTL.BSesVld) is cleared. This discharge time varies between different PHYs and can be obtained from the PHY vendor.</p> <p>0: No session request 1: Session request</p>

Bit	Attr	Reset Value	Description
0	RO	0x0	SesReqScs Session Request Success The core sets this bit when a session request initiation is successful. 0: Session request failure 1: Session request success

USBOTG_GOTGINT

Address: Operational Base + offset (0x0004)

Interrupt Register

Bit	Attr	Reset Value	Description
31:21	RO	0x0	reserved
20	W1C	0x0	MultiValueChg Multi-Valued input changed This bit when set indicates that there is a change in the value of at least one ACA pin value. This bit is present only if OTG_BC_SUPPORT = 1, otherwise it is reserved.
19	W1C	0x0	DbnceDone Debounce Done The core sets this bit when the debounce is completed after the device connect. The application can start driving USB reset after seeing this interrupt. This bit is only valid when the HNP Capable or SRP Capable bit is set in the Core USB Configuration register (GUSBCFG.HNPCap or GUSBCFG.SRPCap, respectively).
18	W1C	0x0	ADevTOUTChg A-Device Timeout Change The core sets this bit to indicate that the A-device has timed out while waiting for the B-device to connect.
17	W1C	0x0	HstNegDet Host Negotiation Detected The core sets this bit when it detects a host negotiation request on the USB
16:10	RO	0x0	reserved

Bit	Attr	Reset Value	Description
9	W1C	0x0	HstNegSucStsChng Host Negotiation Success Status Change The core sets this bit on the success or failure of a USB host negotiation request. The application must read the Host Negotiation Success bit of the OTG Control and Status register (GOTGCTL.HstNegScs) to check for success or failure
8	W1C	0x0	SesReqSucStsChng Session Request Success Status Change The core sets this bit on the success or failure of a session request. The application must read the Session Request Success bit in the OTG Control and Status register (GOTGCTL.SesReqScs) to check for success or failure.
7:3	RO	0x0	reserved
2	W1C	0x0	SesEndDet Session End Detected The core sets this bit when the utmisrp_bvalid signal is deasserted
1:0	RO	0x0	reserved

USBOTG_GAHBCFG

Address: Operational Base + offset (0x0008)

AHB Configuration Register

Bit	Attr	Reset Value	Description
31:23	RO	0x0	reserved

Bit	Attr	Reset Value	Description
22	RW	0x0	<p>NotiAllDmaWrit Notify All Dma Write Transactions This bit is programmed to enable the System DMA Done functionality for all the DMA write Transactions corresponding to the Channel/Endpoint. This bit is valid only when GAHBCFG.RemMemSupp is set to 1. GAHBCFG.NotiAllDmaWrit = 1.</p> <p>HSOTG core asserts int_dma_req for all the DMA write transactions on the AHB interface along with int_dma_done, chep_last_transact and chep_number signal informations. The core waits for sys_dma_done signal for all the DMA write transactions in order to complete the transfer of a particular Channel/Endpoint. GAHBCFG.NotiAllDmaWrit = 0.</p> <p>HSOTG core asserts int_dma_req signal only for the last transaction of DMA write transfer corresponding to a particular Channel/Endpoint. Similarly, the core waits for sys_dma_done signal only for that transaction of DMA write to complete the transfer of a particular Channel/Endpoint.</p>

Bit	Attr	Reset Value	Description
21	RW	0x0	<p>RemMemSupp Remote Memory Support This bit is programmed to enable the functionality to wait for the system DMA Done Signal for the DMA Write Transfers. GAHBCFG.RemMemSupp=1. The int_dma_req output signal is asserted when HSOTG DMA starts write transfer to the external memory. When the core is done with the Transfers it asserts int_dma_done signal to flag the completion of DMA writes from HSOTG. The core then waits for sys_dma_done signal from the system to proceed further and complete the Data Transfer corresponding to a particular Channel/Endpoint. GAHBCFG.RemMemSupp=0. The int_dma_req and int_dma_done signals are not asserted and the core proceeds with the assertion of the XferComp interrupt as soon as the DMA write transfer is done at the HSOTG Core Boundary and it does not wait for the sys_dma_done signal to complete the DATA transfers.</p>
20:9	RO	0x0	reserved
8	RW	0x0	<p>PTxFEmpLvl Periodic TxFIFO Empty Level Indicates when the Periodic TxFIFO Empty Interrupt bit in the Core Interrupt register (GINTSTS.PTxFEmp) is triggered. This bit is used only in Slave mode. 0: GINTSTS.PTxFEmp interrupt indicates that the Periodic TxFIFO is half empty 1: GINTSTS.PTxFEmp interrupt indicates that the Periodic TxFIFO is completely empty</p>

Bit	Attr	Reset Value	Description
7	RW	0x0	<p>NPTxFEmpLvl Non-Periodic TxFIFO Empty Level This bit is used only in Slave mode. In host mode and with Shared FIFO with device mode, this bit indicates when the Non-Periodic TxFIFO Empty Interrupt bit in the Core Interrupt register GINTSTS.NPTxFEmp) is triggered. With dedicated FIFO in device mode, this bit indicates when IN endpoint Transmit FIFO empty interrupt (DIEPINTn.TxFEmp) is triggered.</p> <p>Host mode and with Shared FIFO with device mode: 1'b0: GINTSTS.NPTxFEmp interrupt indicates that the Non-Periodic TxFIFO is half empty 1'b1: GINTSTS.NPTxFEmp interrupt indicates that the Non-Periodic TxFIFO is completely empty</p> <p>Dedicated FIFO in device mode: 1'b0: DIEPINTn.TxFEmp interrupt indicates that the IN Endpoint TxFIFO is half empty 1'b1: DIEPINTn.TxFEmp interrupt indicates that the IN Endpoint TxFIFO is completely empty</p>
6	RO	0x0	reserved
5	RW	0x0	<p>DMAEn DMA Enable 0: Core operates in Slave mode 1: Core operates in a DMA mode This bit is always 0 when Slave-Only mode has been selected.</p>

Bit	Attr	Reset Value	Description
4:1	RW	0x0	<p>HBstLen Burst Length/Type This field is used in both External and Internal DMA modes. In External DMA mode, these bits appear on dma_burst[3:0] ports, External DMA Mode defines the DMA burst length in terms of 32-bit words:</p> <ul style="list-style-type: none"> 4'b0000: 1 word 4'b0001: 4 words 4'b0010: 8 words 4'b0011: 16 words 4'b0100: 32 words 4'b0101: 64 words 4'b0110: 128 words 4'b0111: 256 words Others: Reserved <p>Internal DMA Mode AHB Master burst type:</p> <ul style="list-style-type: none"> 4'b0000: Single 4'b0001: INCR 4'b0011: INCR4 4'b0101: INCR8 4'b0111: INCR16 Others: Reserved
0	RW	0x0	<p>GlblIntrMsk Global Interrupt Mask The application uses this bit to mask or unmask the interrupt line assertion to itself. Irrespective of this bit's setting, the interrupt status registers are updated by the core.</p> <ul style="list-style-type: none"> 1'b0: Mask the interrupt assertion to the application. 1'b1: Unmask the interrupt assertion to the application.

USBOTG_GUSBCFG

Address: Operational Base + offset (0x000c)

USB Configuration Register

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>CorruptTxpacket Corrupt Tx packet This bit is for debug purposes only. Never set this bit to 1.</p>

Bit	Attr	Reset Value	Description
30	RW	0x0	<p>ForceDevMode Force Device Mode Writing a 1 to this bit forces the core to device mode irrespective of utmiotg_iddig input pin. 1'b0: Normal Mode 1'b1: Force Device Mode After setting the force bit, the application must wait at least 25 ms before the change to take effect. When the simulation is in scale down mode, waiting for 500 us is sufficient. This bit is valid only when OTG_MODE = 0, 1 or 2. In all other cases, this bit reads 0.</p>
29	RW	0x0	<p>ForceHstMode Force Host Mode Writing a 1 to this bit forces the core to host mode irrespective of utmiotg_iddig input pin. 1'b0: Normal Mode 1'b1: Force Host Mode After setting the force bit, the application must wait at least 25 ms before the change to take effect. When the simulation is in scale down mode, waiting for 500 us is sufficient. This bit is valid only when OTG_MODE =0, 1 or 2. In allother cases, this bit reads 0.</p>
28	RW	0x0	<p>TxEndDelay Tx End Delay Writing a 1 to this bit enables the TxEndDelay timers in the core. 1'b0: Normal mode 1'b1: Introduce Tx end delay timers</p>
27	RW	0x0	<p>IC_USB_TrafficCtl IC_USB TrafficPullRemove Control When this bit is set, pullup/pulldown resistors are detached from the USB during traffic signaling.This bit is valid only when configuration parameter OTG_ENABLE_IC_USB = 1 and register field GUSBCFG.IC_USBCap is set to 1.</p>

Bit	Attr	Reset Value	Description
26	RW	0x0	<p>IC_USBCap IC_USB-Capable The application uses this bit to control the IC_USB capabilities. 1'b0: IC_USB PHY Interface is not selected. 1'b1: IC_USB PHY Interface is selected. This bit is writable only if OTG_ENABLE_IC_USB=1 and OTG_FSPHY_INTERFACE!=0. The reset value depends on the configuration parameter OTG_SELECT_IC_USB when OTG_ENABLE_IC_USB = 1. In all other cases, this bit is set to 1'b0 and the bit is read only.</p>
25	RW	0x0	<p>ULPIIfDis ULPI Interface Protect Disable Controls circuitry built into the PHY for protecting the ULPI interface when the link tri-states STP and data. Any pull-ups or pull-downs employed by this feature can be disabled. Please refer to the ULPI Specification for more detail. 1'b0: Enables the interface protect circuit 1'b1: Disables the interface protect circuit</p>
24	RW	0x0	<p>IndPassThrough Indicator Pass Through Controls whether the Complement Output is qualified with the Internal Vbus Valid comparator before being used in the Vbus State in the RX CMD. Please refer to the ULPI Specification for more detail. 1'b0: Complement Output signal is qualified with the Internal VbusValid comparator. 1'b1: Complement Output signal is not qualified with the Internal VbusValid comparator.</p>

Bit	Attr	Reset Value	Description
23	RW	0x0	<p>IndComple Indicator Complement Controls the PHY to invert the ExternalVbusIndicator input signal, generating the Complement Output. Please refer to the ULPI Specification for more detail</p> <p>1'b0: PHY does not invert ExternalVbusIndicator signal</p> <p>1'b1: PHY does invert ExternalVbusIndicator signal</p>
22	RW	0x0	<p>TermSelDLPulse TermSel DLine Pulsing Selection This bit selects utmi_termselect to drive data line pulse during SRP.</p> <p>1'b0: Data line pulsing using utmi_txvalid (default).</p> <p>1'b1: Data line pulsing using utmi_termsel.</p>
21	RW	0x0	<p>ULPIExtVbusIndicator ULPI External VBUS Indicator This bit indicates to the ULPI PHY to use an external VBUS over-current indicator.</p> <p>1'b0: PHY uses internal VBUS valid comparator.</p> <p>1'b1: PHY uses external VBUS valid comparator.</p> <p>(Valid only when RTL parameter OTG_HSPHY_INTERFACE = 2 or 3)</p>
20	RW	0x0	<p>ULPIExtVbusDrv ULPI External VBUS Drive This bit selects between internal or external supply to drive 5V on VBUS,in ULPI PHY.</p> <p>1'b0: PHY drives VBUS using internal charge pump (default).</p> <p>1'b1: PHY drives VBUS using external supply.</p> <p>(Valid only when RTL parameter OTG_HSPHY_INTERFACE = 2 or 3)</p>

Bit	Attr	Reset Value	Description
19	RW	0x0	<p>ULPIClkSusM ULPI Clock SuspendM</p> <p>This bit sets the ClockSuspendM bit in the Interface Control register on the ULPI PHY. This bit applies only in serial or carkit modes.</p> <p>1'b0: PHY powers down internal clock during suspend. 1'b1: PHY does not power down internal clock. (Valid only when RTL parameter OTG_HSPHY_INTERFACE = 2 or 3)</p>
18	RW	0x0	<p>ULPIAutoRes ULPI Auto Resume</p> <p>This bit sets the AutoResume bit in the Interface Control register on the ULPI PHY.</p> <p>1'b0: PHY does not use AutoResume feature. 1'b1: PHY uses AutoResume feature. (Valid only when RTL parameter OTG_HSPHY_INTERFACE = 2 or 3)</p>
17	RW	0x0	<p>ULPIFsLs ULPI FS/LS Select</p> <p>The application uses this bit to select the FS/LS serial interface for the ULPI PHY. This bit is valid only when the FS serial transceiver is selected on the ULPI PHY.</p> <p>1'b0: ULPI interface 1'b1: ULPI FS/LS serial interface (Valid only when RTL parameters OTG_HSPHY_INTERFACE = 2 or 3 and OTG_FSPHY_INTERFACE = 1, 2, or 3)</p>
16	RW	0x0	<p>OtgI2CSel UTMIFS or I2C Interface Select</p> <p>The application uses this bit to select the I2C interface.</p> <p>1'b0: UTMIFS USB 1.1 Full-Speed interface for OTG signals 1'b1: I2C interface for OTG signals This bit is writable only if I2C and UTMIFS were specified for Enable I2C Interface? (parameter OTG_I2C_INTERFACE = 2). Otherwise, reads return 0.</p>

Bit	Attr	Reset Value	Description
15	RW	0x0	<p>PhyLPwrClkSel PHY Low-Power Clock Select Selects either 480-MHz or 48-MHz (low-power) PHY mode. In FS and LS modes, the PHY can usually operate on a 48-MHz clock to save power.</p> <p>1'b0: 480-MHz Internal PLL clock 1'b1: 48-MHz External Clock In 480 MHz mode, the UTMI interface operates at either 60 or 30-MHz, depending upon whether 8- or 16-bit data width is selected. In 48-MHz mode, the UTMI interface operates at 48 MHz in FS and LS modes. This bit drives the utmi_fs_ls_low_power core output signal, and is valid only for UTMI+ PHYs.</p>
14	RO	0x0	reserved
13:10	RW	0x5	<p>USBTrdTim USB Turnaround Time Sets the turnaround time in PHY clocks. Specifies the response time for a MAC request to the Packet FIFO Controller (PFC) to fetch data from the DFIF(SPRAM). This must be programmed to</p> <p>4'h5: When the MAC interface is 16-bit UTMI+. 4'h9: When the MAC interface is 8-bit UTMI+. Note: The values above are calculated for the minimum AHB frequency of 30 MHz. USB turnaround time is critical for certification where long cables and 5-Hubs are used, so if you need the AHB to run at less than 30 MHz, and if USB turnaround time is not critical, these bits can be programmed to a larger value.</p>
9	RW	0x0	<p>HNPCap HNP-Capable The application uses this bit to control the otg core's HNP capabilities.</p> <p>0: HNP capability is not enabled. 1: HNP capability is enabled. This bit is writable only if an HNP mode was specified for Mode of Operation (parameter OTG_MODE). Otherwise, reads return 0.</p>

Bit	Attr	Reset Value	Description
8	RW	0x0	<p>SRPCap SRP-Capable</p> <p>The application uses this bit to control the otg core SRP capabilities. If the core operates as a non-SRP-capable B-device, it cannot request the connected A-device (host) to activate VBUS and start a session.</p> <p>0: SRP capability is not enabled. 1: SRP capability is enabled.</p> <p>This bit is writable only if an SRP mode was specified for Mode of Operation (parameter OTG_MODE). Otherwise, reads return 0.</p>
7	RW	0x0	<p>DDRSel ULPI DDR Select</p> <p>The application uses this bit to select a Single Data Rate (SDR) or Double Data Rate (DDR) or ULPI interface.</p> <p>0: Single Data Rate ULPI Interface, with 8-bit-wide data bus 1: Double Data Rate ULPI Interface, with 4-bit-wide data bus</p>
6	RW	0x0	<p>PHYSel</p> <p>USB 2.0 High-Speed PHY or USB 1.1 Full-Speed Serial Transceiver</p> <p>The application uses this bit to select either a high-speed UTMI+ or ULPI PHY, or a full-speed transceiver.</p> <p>0: USB 2.0 high-speed UTMI+ or ULPI PHY 1: USB 1.1 full-speed serial transceiver</p> <p>If a USB 1.1 Full-Speed Serial Transceiver interface was not selected (parameter OTG_FSPHY_INTERFACE = 0), this bit is always 0, with Write Only access. If a high-speed PHY interface was not selected (parameter OTG_HSPHY_INTERFACE = 0), this bit is always 1, with Write Only access.</p> <p>If both interface types were selected (parameters have non-zero values), the application uses this bit to select which interface is active, and access is Read and Write.</p>

Bit	Attr	Reset Value	Description
5	RW	0x0	<p>FSIntf Full-Speed Serial Interface Select The application uses this bit to select either a unidirectional or bidirectional USB 1.1 full-speed serial transceiver interface.</p> <p>0: 6-pin unidirectional full-speed serial interface 1: 3-pin bidirectional full-speed serial interface</p> <p>If a USB 1.1 Full-Speed Serial Transceiver interface was not selected (parameter OTG_FSPHY_INTERFACE = 0), this bit is always 0, with Write Only access. If a USB 1.1 FS interface was selected (parameter OTG_FSPHY_INTERFACE! = 0), then the application can set this bit to select between the 3- and 6-pin interfaces, and access is Read and Write.</p>
4	RW	0x0	<p>ULPI_UTMI_Sel ULPI or UTMI+ Select The application uses this bit to select either a UTMI+ interface or ULPI Interface.</p> <p>0: UTMI+ Interface 1: ULPI Interface</p> <p>This bit is writable only if UTMI+ and ULPI was specified for High-Speed PHY Interface(s) (parameter OTG_HSPHY_INTERFACE = 3). Otherwise, reads return either 0 or 1, depending on the interface selected using the OTG_HSPHY_INTERFACE parameter.</p>
3	RW	0x0	<p>PHYIf PHY Interface The application uses this bit to configure the core to support a UTMI+ PHY with an 8- or 16-bit interface. When a ULPI PHY is chosen, this must be set to 8-bit mode.</p> <p>0: 8 bits 1: 16 bits</p> <p>This bit is writable only if UTMI+ and ULPI were selected (parameter OTG_HSPHY_DWIDTH = 3). Otherwise, this bit returns the value for the power-on interface selected during configuration.</p>

Bit	Attr	Reset Value	Description
2:0	RW	0x0	<p>TOutCal HS/FS Timeout Calibration The number of PHY clocks that the application programs in this field is added to the high-speed/full-speed interpacket timeout duration in the core to account for any additional delays introduced by the PHY. This can be required, because the delay introduced by the PHY in generating the line state condition can vary from one PHY to another. The USB standard timeout value for high-speed operation is 736 to 816 (inclusive) bit times. The USB standard timeout value for full-speed operation is 16 to 18 (inclusive) bit times. The application must program this field based on the speed of enumeration. The number of bit times added per PHY clock are: High-speed operation: One 30-MHz PHY clock = 16 bit times One 60-MHz PHY clock = 8 bit times Full-speed operation: One 30-MHz PHY clock = 0.4 bit times One 60-MHz PHY clock = 0.2 bit times One 48-MHz PHY clock = 0.25 bit times</p>

USBOTG_GRSTCTL

Address: Operational Base + offset (0x0010)
Reset Register

Bit	Attr	Reset Value	Description
31	RO	0x1	AHBIdle AHB Master Idle Indicates that the AHB Master State Machine is in the IDLE condition.
30	RO	0x0	DMAReq DMA Request Signal Indicates that the DMA request is in progress. Used for debug.
29:11	RO	0x0	reserved

Bit	Attr	Reset Value	Description
10:6	RW	0x00	<p>TxFNum Tx FIFO Number This is the FIFO number that must be flushed using the Tx FIFO Flush bit. This field must not be changed until the core clears the Tx FIFO Flush bit.</p> <p>5'h0: Non-periodic Tx FIFO flush in Host mode; Non-periodic Tx FIFO flush in device mode when in shared FIFO operation. Tx FIFO 0 flush in device mode when in dedicated FIFO mode.</p> <p>5'h1: Periodic Tx FIFO flush in Host mode: Periodic Tx FIFO 1 flush in Device mode when in shared FIFO operation; TX FIFO 1 flush in device mode when in dedicated FIFO mode.</p> <p>5'h2: Periodic Tx FIFO 2 flush in Device mode when in shared FIFO operation: TX FIFO 2 flush in device mode when in dedicated FIFO mode.</p> <p>...</p> <p>5'hF: Periodic Tx FIFO 15 flush in Device mode when in shared FIFO operation: TX FIFO 15 flush in device mode when in dedicated FIFO mode.</p> <p>5'h10: Flush all the transmit FIFOs in device or host mode.</p>

Bit	Attr	Reset Value	Description
5	RWSC	0x0	<p>TxFFlsh TxFIFO Flush</p> <p>This bit selectively flushes a single or all transmit FIFOs, but cannot do so if the core is in the midst of a transaction. The application must write this bit only after checking that the core is neither writing to the Tx FIFO nor reading from the Tx FIFO. Verify using these registers: Read NAK Effective Interrupt ensures the core is not reading from the FIFO. Write GRSTCTL.AHBIdle ensures the core is not writing anything to the FIFO.</p> <p>Flushing is normally recommended when FIFOs are re-configured or when switching between Shared FIFO and Dedicated Transmit FIFO operation. FIFO flushing is also recommended during device endpoint disable. The application must wait until the core clears this bit before performing any operations. This bit takes eight clocks to clear, using the slower clock of phy_clk or hclk.</p>
4	RWSC	0x0	<p>RxFFlsh RxFIFO Flush</p> <p>The application can flush the entire Rx FIFO using this bit, but must first ensure that the core is not in the middle of a transaction. The application must only write to this bit after checking that the core is neither reading from the Rx FIFO nor writing to the Rx FIFO. The application must wait until the bit is cleared before performing any other operations. This bit requires 8 clocks (slowest of PHY or AHB clock) to clear.</p>
3	RWSC	0x0	<p>INTknQFlsh IN Token Sequence Learning Queue Flush</p> <p>This bit is valid only if OTG_EN_DED_TX_FIFO = 0. The application writes this bit to flush the IN Token Sequence Learning Queue.</p>

Bit	Attr	Reset Value	Description
2	W1C	0x0	FrmCntrRst Host Frame Counter Reset The application writes this bit to reset the (micro)frame number counter inside the core. When the (micro)frame counter is reset, the subsequent SOF sent out by the core has a (micro)frame number of 0.
1	RWSC	0x0	Reset A write to this bit issues a soft reset to the otg_power_dn module of the core.

Bit	Attr	Reset Value	Description
0	RWSC	0x0	<p>CSftRst Core Soft Reset Resets the hclk and phy_clock domains as follows: Clears the interrupts and all the CSR registers except the following register bits:</p> <ul style="list-style-type: none"> PCGCCTL.RstPdwnModule PCGCCTL.GateHclk PCGCCTL.PwrClmp PCGCCTL.StopPPhyLPwrClkSelClk GUSBCFG.PhyLPwrClkSel GUSBCFG.DDRSel GUSBCFG.PHYSel GUSBCFG.FSIntf GUSBCFG.ULPI_UTMI_Sel GUSBCFG.PHYIf HCFG.FSLSPclkSel DCFG.DevSpd GPIO GPWRDN GADPCTL <p>All module state machines (except the AHB Slave Unit) are reset to the IDLE state, and all the transmit FIFOs and the receive FIFO are flushed. Any transactions on the AHB Master are terminated as soon as possible, after gracefully completing the last data phase of an AHB transfer. Any transactions on the USB are terminated immediately. When Hibernation or ADP feature is enabled, the PMU module is not reset by the Core Soft Reset. The application can write to this bit any time it wants to reset the core. This is a self-clearing bit and the core clears this bit after all the necessary logic is reset in the core, which can take several clocks, depending on the current state of the core.</p> <p>Once this bit is cleared software must wait at least 3 PHY clocks before doing any access to the PHY domain (synchronization delay). Software must also check that bit 31 of this register is 1 (AHB Master is IDLE) before starting any operation. Typically software reset is used during software development and also when you dynamically change the PHY selection bits in the USB configuration registers listed above. When you change the PHY1 the corresponding clock for the PHY is selected and used in the PHY domain. Once a new clock is selected, the PHY domain has to be reset for</p>

USBOTG_GINTSTS

Address: Operational Base + offset (0x0014)

Interrupt Register

Bit	Attr	Reset Value	Description
31	W1C	0x0	<p>WkUpInt Resume/Remote Wakeup Detected Interrupt Wakeup Interrupt during Suspend(L2) or LPM(L1) state.</p> <p>During Suspend(L2): Device Mode:This interrupt is asserted only when Host Initiated Resume is detected on USB. Host Mode:This interrupt is asserted only when Device Initiated Remote Wakeup is detected on USB.</p> <p>During LPM(L1): Device Mode:This interrupt is asserted for either Host Initiated Resume or Device Initiated Remote Wakeup on USB. Host Mode:This interrupt is asserted for either Host Initiated Resume or Device Initiated Remote Wakeup on USB.</p>
30	W1C	0x0	<p>SessReqInt Session Request/New Session Detected Interrupt</p> <p>In Host mode, this interrupt is asserted when a session request is detected from the device. In Host mode, this interrupt is asserted when a session request is detected from the device. In Device mode, this interrupt is asserted when the utmisrp_bvalid signal goes high.</p>
29	W1C	0x0	<p>DisconnInt Disconnect Detected Interrupt</p> <p>This interrupt is asserted when a device disconnect is detected.</p>
28	W1C	0x0	<p>ConIDStsChng Connector ID Status Change</p> <p>This interrupt is asserted when there is a change in connector ID status.</p>

Bit	Attr	Reset Value	Description
27	W1C	0x0	<p>LPM_Int LPM Transaction Received Interrupt Device Mode : This interrupt is asserted when the device receives an LPM transaction and responds with a non-ERRORed response. Host Mode : This interrupt is asserted when the device responds to an LPM transaction with a non-ERRORed response or when the host core has completed LPM transactions for the programmed number of times (GLPMCFG.RetryCnt). This field is valid only if the Core LPM Configuration register's LPMCapable (LPMCap) field is set to 1.</p>
26	RO	0x0	<p>PTxFEmp Periodic TxFIFO Empty This interrupt is asserted when the Periodic Transmit FIFO is either half or completely empty and there is space for at least one entry to be written in the Periodic Request Queue. The half or completely empty status is determined by the Periodic TxFIFO Empty Level bit in the Core AHB Configuration register (GAHBCFG.PTxFEmpLvl).</p>
25	RO	0x0	<p>HChInt Host Channels Interrupt The core sets this bit to indicate that an interrupt is pending on one of the channels of the core (in Host mode). The application must read the Host All Channels Interrupt (HAINT) register to determine the exact number of the channel on which the interrupt occurred, and then read the corresponding Host Channel-n Interrupt (HCINTn) register to determine the exact cause of the interrupt. The application must clear the appropriate status bit in the HCINTn register to clear this bit.</p>

Bit	Attr	Reset Value	Description
24	RO	0x0	PrtInt Host Port Interrupt The core sets this bit to indicate a change in port status of one of the otg core ports in Host mode. The application must read the Host Port Control and Status (HPRT) register to determine the exact event that caused this interrupt. The application must clear the appropriate status bit in the Host Port Control and Status register to clear this bit.
23	RW	0x0	ResetDet Reset Detected Interrupt The core asserts this interrupt in Device mode when it detects a reset on the USB in Partial Power-Down mode when the device is in Suspend. This interrupt is not asserted in Host mode.

Bit	Attr	Reset Value	Description
22	W1C	0x0	<p>FetSusp Data Fetch Suspended</p> <p>This interrupt is valid only in DMA mode. This interrupt indicates that the core has stopped fetching data for IN endpoints due to the unavailability of TxFIFO space or Request Queue space. This interrupt is used by the application for an endpoint mismatch algorithm. For example, after detecting an endpoint mismatch, the application: Sets a global non-periodic IN NAK handshake, Disables In endpoints, Flushes the FIFO, Determines the token sequence from the IN Token Sequence Learning Queue, Re-enables the endpoints, Clears the global non-periodic IN NAK handshake. If the global non-periodic IN NAK is cleared, the core has not yet fetched data for the IN endpoint, and the IN token is received: the core generates an "IN token received when FIFO empty" interrupt. The OTG then sends the host a NAK response. To avoid this scenario, the application can check the GINTSTS.FetSusp interrupt, which ensures that the FIFO is full before clearing a global NAK handshake. Alternatively, the application can mask the IN token received when FIFO empty?interrupt when clearing a global IN NAK handshake.</p>
21	W1C	0x0	<p>incomplP Incomplete Periodic Transfer</p> <p>In Host mode, the core sets this interrupt bit when there are incomplete periodic transactions still pending which are scheduled for the current microframe. Incomplete Isochronous OUT Transfer (incompISOOUT) The Device mode, the core sets this interrupt to indicate that there is at least one isochronous OUT endpoint on which the transfer is not completed in the current microframe. This interrupt is asserted along with the End of Periodic Frame Interrupt (EOPF) bit in this register.</p>

Bit	Attr	Reset Value	Description
20	W1C	0x0	<p>incompISOIN Incomplete Isochronous IN Transfer The core sets this interrupt to indicate that there is at least one isochronous IN endpoint on which the transfer is not completed in the current microframe. This interrupt is asserted along with the End of Periodic Frame Interrupt (EOPF) bit in this register. Note: This interrupt is not asserted in Scatter/Gather DMA mode.</p>
19	RO	0x0	<p>OEPInt OUT Endpoints Interrupt The core sets this bit to indicate that an interrupt is pending on one of the OUT endpoints of the core (in Device mode). The application must read the Device All Endpoints Interrupt (DAINT) register to determine the exact number of the OUT endpoint on which the interrupt occurred, and then read the corresponding Device OUT Endpoint-n Interrupt (DOEPINTn) register to determine the exact cause of the interrupt. The application must clear the appropriate status bit in the corresponding DOEPINTn register to clear this bit.</p>
18	RO	0x0	<p>IEPInt IN Endpoints Interrupt The core sets this bit to indicate that an interrupt is pending on one of the IN endpoints of the core (in Device mode). The application must read the Device All Endpoints Interrupt (DAINT) register to determine the exact number of the IN endpoint on which the interrupt occurred, and then read the corresponding Device IN Endpoint-n Interrupt (DIEPINTn) register to determine the exact cause of the interrupt. The application must clear the appropriate status bit in the corresponding DIEPINTn register to clear this bit.</p>

Bit	Attr	Reset Value	Description
17	W1C	0x0	EPMIs Endpoint Mismatch Interrupt Note: This interrupt is valid only in shared FIFO operation. Indicates that an IN token has been received for a non-periodic endpoint, but the data for another endpoint is present in the top of the Non-periodic Transmit FIFO and the IN endpoint mismatch count programmed by the application has expired.
16	W1C	0x0	RstrDoneInt Restore Done Interrupt The core sets this bit to indicate that the restore command after Hibernation was completed by the core. The core continues from Suspended state into the mode dictated by PCGCCTL.RestoreMode field. This bit is valid only when Hibernation feature is enabled.
15	W1C	0x0	EOPF End of Periodic Frame Interrupt Indicates that the period specified in the Periodic Frame Interval field of the Device Configuration register (DCFG.PerFrInt) has been reached in the current microframe.
14	W1C	0x0	ISOOutDrop Isochronous OUT Packet Dropped Interrupt The core sets this bit when it fails to write an isochronous OUT packet into the RxFIFO because the RxFIFO does not have enough space to accommodate a maximum packet size packet for the isochronous OUT endpoint.
13	W1C	0x0	EnumDone Enumeration Done The core sets this bit to indicate that speed enumeration is complete. The application must read the Device Status (DSTS) register to obtain the enumerated speed.
12	W1C	0x0	USBRst USB Reset The core sets this bit to indicate that a reset is detected on the USB.

Bit	Attr	Reset Value	Description
11	W1C	0x0	USBSusp USB Suspend The core sets this bit to indicate that a suspend was detected on the USB. The core enters the Suspended state when there is no activity on the utmi_lonestate signal for an extended period of time.
10	W1C	0x0	ErlySusp Early Suspend The core sets this bit to indicate that an Idle state has been detected on the USB for 3 ms.
9	W1C	0x0	I2CINT I2C Interrupt The core sets this interrupt when I2C access is completed on the I2C interface. This field is used only if the I2C interface was enabled . Otherwise, reads return 0.
8	W1C	0x0	ULPICKINT ULPI Carkit Interrupt This field is used only if the Carkit interface was enabled . Otherwise, reads return 0. The core sets this interrupt when a ULPI Carkit interrupt is received. The core's PHY sets ULPI Carkit interrupt in UART or Audio mode. I2C Carkit Interrupt (I2CCKINT) This field is used only if the I2C interface was enabled . Otherwise, reads return 0.The core sets this interrupt when a Carkit interrupt is received. The core's PHY sets the I2C Carkit interrupt in Audio mode.
7	RO	0x0	GOUTNakEff Global OUT NAK Effective Indicates that the Set Global OUT NAK bit in the Device Control register DCTL.SGOUTNak), set by the application, has taken effect in the core. This bit can be cleared by writing the Clear Global OUT NAK bit in the Device Control register (DCTL.CGOUTNak).

Bit	Attr	Reset Value	Description
6	RO	0x0	GINNakEff Global IN Non-Periodic NAK Effective Indicates that the Set Global Non-periodic IN NAK bit in the Device Control register (DCTL.SGNPInNak), set by the application, has taken effect in the core. That is, the core has sampled the Global IN NAK bit set by the application. This bit can be cleared by clearing the Clear Global Nonperiodic IN NAK bit in the Device Control register (DCTL.CGNPInNak). This interrupt does not necessarily mean that a NAK handshake is sent out on the USB. The STALL bit takes precedence over the NAK bit.
5	RO	0x0	NPTxFEmp Non-Periodic Tx FIFO Empty This interrupt is valid only when OTG_ENDED_TX_FIFO = 0. This interrupt is asserted when the Non-periodic Tx FIFO is either half or completely empty, and there is space for at least one entry to be written to the Non-periodic Transmit Request Queue. The half or completely empty status is determined by the Non-periodic Tx FIFO Empty Level bit in the Core AHB Configuration register(GAHBCFG.NPTxFEmpLvl).
4	RO	0x0	RxFLvl Rx FIFO Non-Empty Indicates that there is at least one packet pending to be read from the Rx FIFO.
3	W1C	0x0	Sof Start of (micro)Frame In Host mode, the core sets this bit to indicate that an SOF (FS), micro-SOF(HS), or Keep-Alive (LS) is transmitted on the USB. The application must write a 1 to this bit to clear the interrupt. In Device mode, in the core sets this bit to indicate that an SOF token has been received on the USB. The application can read the Device Status register to get the current (micro)frame number. This interrupt is seen only when the core is operating at either HS or FS.

Bit	Attr	Reset Value	Description
2	RO	0x0	<p>OTGInt OTG Interrupt</p> <p>The core sets this bit to indicate an OTG protocol event. The application must read the OTG Interrupt Status (GOTGINT) register to determine the exact event that caused this interrupt. The application must clear the appropriate status bit in the GOTGINT register to clear this bit.</p>
1	W1C	0x0	<p>ModeMis Mode Mismatch Interrupt</p> <p>The core sets this bit when the application is trying to access: A Host mode register, when the core is operating in Device mode ; A Device mode register, when the core is operating in Host mode. The register access is completed on the AHB with an OKAY response, but is ignored by the core internally and does not affect the operation of the core.</p>
0	RO	0x0	<p>CurMod Current Mode of Operation</p> <p>Indicates the current mode.</p> <p>1'b0: Device mode 1'b1: Host mode</p>

USBOTG_GINTMSK

Address: Operational Base + offset (0x0018)

Interrupt Mask Register

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>WkUpIntMsk</p> <p>Resume/Remote Wakeup Detected Interrupt Mask</p>
30	RW	0x0	<p>SessReqIntMsk</p> <p>Session Request/New Session Detected Interrupt Mask</p>
29	RW	0x0	<p>DisconnIntMsk</p> <p>Disconnect Detected Interrupt Mask</p>
28	RW	0x0	<p>ConIDStsChngMsk</p> <p>Connector ID Status Change Mask</p>
27	RW	0x0	<p>LPM_IntMsk</p> <p>LPM Transaction Received Interrupt Mask</p>
26	RW	0x0	<p>PTxFEmpMsk</p> <p>Periodic TxFIFO Empty Mask</p>

Bit	Attr	Reset Value	Description
25	RW	0x0	HChIntMsk Host Channels Interrupt Mask
24	RW	0x0	PrtIntMsk Host Port Interrupt Mask
23	RW	0x0	ResetDetMsk Reset Detected Interrupt Mask
22	RW	0x0	FetSuspMsk Data Fetch Suspended Mask
21	RW	0x0	incompIPMsk_incompISOOUTMsk Incomplete Periodic Transfer Mask(Host only) Incomplete Isochronous OUT Transfer Mask(Device only)
20	RW	0x0	incompISOINMsk Incomplete Isochronous IN Transfer Mask
19	RW	0x0	OEPIntMsk OUT Endpoints Interrupt Mask
18	RW	0x0	IEPIntMsk IN Endpoints Interrupt Mask
17	RW	0x0	EPMisMsk Endpoint Mismatch Interrupt Mask
16	RW	0x0	RstrDoneIntMsk Restore Done Interrupt Mask This field is valid only when Hibernation feature is enabled.
15	RW	0x0	EOPFMsk End of Periodic Frame Interrupt Mask
14	RW	0x0	ISOOutDropMsk Isochronous OUT Packet Dropped Interrupt Mask
13	RW	0x0	EnumDoneMsk Enumeration Done Mask
12	RW	0x0	USBRstMsk USB Reset Mask
11	RW	0x0	USBSuspMsk USB Suspend Mask
10	RW	0x0	ErlySuspMsk Early Suspend Mask
9	RW	0x0	I2CIntMsk I2C Interrupt Mask
8	RW	0x0	ULPICKINTMsk_I2CCKINTMsk ULPI Carkit Interrupt Mask (ULPICKINTMsk) I2C Carkit Interrupt Mask (I2CCKINTMsk)

Bit	Attr	Reset Value	Description
7	RW	0x0	GOUTNakEffMsk Global OUT NAK Effective Mask
6	RW	0x0	GINNakEffMsk Global Non-periodic IN NAK Effective Mask
5	RW	0x0	NPTxFEEmpMsk Non-periodic TxFIFO Empty Mask
4	RW	0x0	RxFLvlMsk Receive FIFO Non-Empty Mask
3	RW	0x0	SofMsk Start of (micro)Frame Mask
2	RW	0x0	OTGIntMsk OTG Interrupt Mask
1	RW	0x0	ModeMisMsk Mode Mismatch Interrupt Mask
0	RO	0x0	reserved

USBOTG_GRXSTSR

Address: Operational Base + offset (0x001c)

Receive Status Debug Read Register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved
24:21	RO	0x0	FN Frame Number (Device Only) This is the least significant 4 bits of the (micro)frame number in which the packet is received on the USB. This field is supported only when isochronous OUT endpoints are supported.

Bit	Attr	Reset Value	Description
20:17	RO	0x0	<p>PktSts Packet Status Indicates the status of the received packet(Host Only)</p> <ul style="list-style-type: none"> 4'b0010: IN data packet received 4'b0011: IN transfer completed (triggers an interrupt) 4'b0101: Data toggle error (triggers an interrupt) 4'b0111: Channel halted (triggers an interrupt) Others: Reserved <p>Indicates the status of the received packet(Device only)</p> <ul style="list-style-type: none"> 4'b0001: Global OUT NAK (triggers an interrupt) 4'b0010: OUT data packet received 4'b0011: OUT transfer completed (triggers an interrupt) 4'b0100: SETUP transaction completed (triggers an interrupt) 4'b0110: SETUP data packet received Others: Reserved
16:15	RO	0x0	<p>DPID Data PID Indicates the Data PID of the received packet</p> <ul style="list-style-type: none"> 2'b00: DATA0 2'b10: DATA1 2'b01: DATA2 2'b11: MDATA
14:4	RW	0x000	<p>BCnt Byte Count Indicates the byte count of the received data packet.</p>
3:0	RO	0x0	<p>ChNum_EPNum Channel Number(Host) Endpoint Number(Device) (Host Only) Indicates the channel number to which the current received packet belongs. (Device Only) Indicates the endpoint number to which the current received packet belongs.</p>

USBOTG_GRXSTSP

Address: Operational Base + offset (0x0020)

Receive Status Read and Pop Register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved
24:21	RO	0x0	<p>FN Frame Number (Device Only) This is the least significant 4 bits of the (micro)frame number in which the packet is received on the USB. This field is supported only when isochronous OUT endpoints are supported.</p>
20:17	RO	0x0	<p>PktSts Packet Status Indicates the status of the received packet(Host Only) 4'b0010: IN data packet received 4'b0011: IN transfer completed (triggers an interrupt) 4'b0101: Data toggle error (triggers an interrupt) 4'b0111: Channel halted (triggers an interrupt) Others: Reserved Indicates the status of the received packet(Device only) 4'b0001: Global OUT NAK (triggers an interrupt) 4'b0010: OUT data packet received 4'b0011: OUT transfer completed (triggers an interrupt) 4'b0100: SETUP transaction completed (triggers an interrupt) 4'b0110: SETUP data packet received Others: Reserved</p>
16:15	RO	0x0	<p>DPID Data PID Indicates the Data PID of the received OUT data packet 2'b00: DATA0 2'b10: DATA1 2'b01: DATA2 2'b11: MDATA</p>

Bit	Attr	Reset Value	Description
14:4	RO	0x000	BCnt Byte Count Indicates the byte count of the received data packet.
3:0	RO	0x0	ChNum_EPNum Channel Number(Host) Endpoint Number(Device) (Host Only) Indicates the channel number to which the current received packet belongs. (Device Only) Indicates the endpoint number to which the current received packet belongs.

USBOTG_GRXFSIZ

Address: Operational Base + offset (0x0024)

Receive FIFO Size Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	RxFDep RxFIFO Depth This value is in terms of 32-bit words. Minimum value is 16, Maximum value is 32,768. The power-on reset value of this register is specified as the Largest Rx Data FIFO Depth. If Enable Dynamic FIFO Sizing? was deselected, these flops are optimized, and reads return the power-on value. If Enable Dynamic FIFO Sizing? was selected , you can write a new value in this field. You can write a new value in this field. Programmed values must not exceed the power-on value.

USBOTG_GNPTXFSIZ

Address: Operational Base + offset (0x0028)

Non-Periodic Transmit FIFO Size Register (Host mode)

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>NPTxFDep Non-periodic TxFIFO For host mode, this field is always valid. For Device mode, this field is valid only when OTG_ENDED_TX_FIFO==0. This value is in terms of 32-bit words. Minimum value is 16 Maximum value is 32,768 This field is determined by Enable Dynamic FIFO Sizing. OTG_DFIFO_DYNAMIC = 0: These flops are optimized, and reads return the power-on value. OTG_DFIFO_DYNAMIC = 1: The application can write a new value in this field. Programmed values must not exceed the power-on value. The power-on reset value of this field is specified by OTG_ENDED_TX_FIFO: OTG_ENDED_TX_FIFO = 0: The reset value is the Largest Non-periodic Tx Data FIFO Depth parameter, OTG_TX_NPERIO_DFIFO_DEPTH. OTG_ENDED_TX_FIFO = 1: The reset value is parameter OTG_TX_HNPERIO_DFIFO_DEPTH.</p>
15:0	RW	0x0000	<p>NPTxFStAddr Non-periodic Transmit RAM For host mode, this field is always valid. This field contains the memory start address for Non-periodic Transmit FIFO RAM. This field is determined by Enable Dynamic FIFO Sizing?(OTG_DFIFO_DYNAMIC): OTG_DFIFO_DYNAMIC = 0 :These flops are optimized, and reads return the power-on value. OTG_DFIFO_DYNAMIC = 1 :The application can write a new value in this field. Programmed values must not exceed the power-on value. The power-on reset value of this field is specified by Largest Rx Data FIFO Depth (parameter OTG_RX_DFIFO_DEPTH).</p>

Non-Periodic Transmit FIFO Size Register (Device mode)

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>INEPTxF0Dep IN Endpoint TxFIFO 0 Depth This field is valid only for Device mode and when OTG_ENDED_TX_FIFO = 1 This value is in terms of 32-bit words. Minimum value is 16 Maximum value is 32,768 This field is determined by Enable Dynamic FIFO Sizing? (OTG_TX_DINEP_DFIFO_DEPTH_0): OTG_DFIFO_DYNAMIC = 0—These flops are optimized, and reads return the power-on value. OTG_DFIFO_DYNAMIC = 1—Programmed values must not exceed the power-on value. The power-on reset value of this field is specified as Largest IN Endpoint FIFO 0 Depth (parameter OTG_TX_DINEP_DFIFO_DEPTH_0).</p>
15:0	RW	0x0000	<p>INEPTxF0StAddr IN Endpoint FIFO0 Transmit RAM Start Address For Device mode this field is valid only when OTG_ENDED_TX_FIFO = 0 This field contains the memory start address for IN Endpoint Transmit FIFO# 0. OTG_RX_DFIFO_DEPTH This field is determined by Enable Dynamic FIFO Sizing? (OTG_DFIFO_DYNAMIC): OTG_DFIFO_DYNAMIC = 0 —These flops are optimized, and reads return the power-on value. OTG_DFIFO_DYNAMIC = 1—The application can write a new value in this field. Programmed values must not exceed the power-on value. The power-on reset value of this register is specified as the Largest Rx Data FIFO Depth (parameter OTG_RX_DFIFO_DEPTH).</p>

USBOTG_GNPTXSTS

Address: Operational Base + offset (0x002c)

Non-Periodic Transmit FIFO/Queue Status Register

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved

Bit	Attr	Reset Value	Description
30:24	RO	0x00	<p>NPTxQTop Top of the Non-periodic Transmit Request Queue</p> <p>Entry in the Non-periodic Tx Request Queue that is currently being processed by the MAC.</p> <p>Bits [30:27]: Channel/endpoint number</p> <p>Bits [26:25]:</p> <ul style="list-style-type: none"> 2'b00: IN/OUT token 2'b01: Zero-length transmit packet (device IN/host OUT) 2'b10: PING/CSPLIT token 2'b11: Channel halt command <p>Bit [24]: Terminate (last entry for selected channel/endpoint)</p>
23:16	RO	0x00	<p>NPTxQSpAvail Non-periodic Transmit Request Queue Space Available</p> <p>Indicates the amount of free space available in the Non-periodic Transmit Request Queue. This queue holds both IN and OUT requests in Host mode. Device mode has only IN requests.</p> <p>8'h0: Non-periodic Transmit Request Queue is full</p> <p>8'h1: 1 location available</p> <p>8'h2: 2 locations available</p> <p>n: n locations available (0 <=n <= 8)</p> <p>Others: Reserved</p>
15:0	RO	0x0000	<p>NPTxFSpAvail Non-periodic TxFIFO Space Avail</p> <p>Indicates the amount of free space available in the Non-periodic TxFIFO. Values are in terms of 32-bit words.</p> <p>16'h0: Non-periodic TxFIFO is full</p> <p>16'h1: 1 word available</p> <p>16'h2: 2 words available</p> <p>16'hn: n words available (where 0 <=n <=32,768)</p> <p>16'h8000: 32,768 words available</p> <p>Others: Reserved</p>

USBOTG_GI2CCTL

Address: Operational Base + offset (0x0030)

I2C Address Register

Bit	Attr	Reset Value	Description
31	RWSC	0x0	BsyDne I2C Busy/Done The application sets this bit to 1'b1 to start a request on the I2C interface. When the transfer is complete, the core deasserts this bit to 1'b0. As long as the bit is set, indicating that the I2C interface is busy, the application cannot start another request on the interface.
30	RW	0x0	RW Read/Write Indicator Indicates whether a read or write register transfer must be performed on the interface. Read/write bursting is not supported for registers. 1'b1: Read 1'b0: Write
29	RO	0x0	reserved
28	RW	0x1	I2CDatSe0 I2C DatSe0 USB Mode Selects the FS interface USB mode. 1'b1: VP_VM USB mode 1'b0: DAT_SE0 USB mode
27:26	RW	0x0	I2CDevAdr I2C Device Address Selects the address of the I2C Slave on the USB 1.1 full-speed serial transceiver that the core uses for OTG signaling. 2'b00: 7'h2C 2'b01: 7'h2D 2'b10: 7'h2E 2'b11: 7'h2F
25	RW	0x0	I2CSuspCtl I2C Suspend Control Selects how Suspend is connected to a full-speed transceiver in I2C mode. 1'b0: Use the dedicated utmi_suspend_n pin 1'b1: Use an I2C write to program the Suspend bit in the PHY register

Bit	Attr	Reset Value	Description
24	RO	0x1	Ack I2C ACK Indicates whether an ACK response was received from the I2C Slave. This bit is valid when BsyDne is cleared by the core, after application has initiated an I2C access. 1'b0: NAK 1'b1: ACK
23	RW	0x0	I2CEn I2C Enable Enables the I2C Master to initiate I2C transactions on the I2C interface
22:16	RW	0x00	Addr I2C Address This is the 7-bit I2C device address used by software to access any external I2C Slave, including the I2C Slave on a USB 1.1 OTG full-speed serial transceiver. Software can change this address to access different I2C Slaves.
15:8	RW	0x00	RegAddr I2C Register Addr This field programs the address of the register to be read from or written to.
7:0	RW	0x00	RWData I2C Read/Write Data After a register read operation, this field holds the read data for the application. During a write operation, the application can use this register to program the write data to be written to a register. During writes, this field holds the write data.

USBOTG_GPVNDCTL

Address: Operational Base + offset (0x0034)

PHY Vendor Control Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31	RWSC	0x0	DisUlpiDrvr Disable ULPI Drivers This field is used only if the Carkit interface was enabled (parameter OTG_ULPI_CARKIT = 1). Otherwise, reads return 0. The application sets this bit when it has finished processing the ULPI Carkit Interrupt (GINTSTS.ULPICKINT). When set, the otg core disables drivers for output signals and masks input signal for the ULPI interface. Otg clears this bit before enabling the ULPI interface.
30:28	RO	0x0	reserved
27	RWSC	0x0	VStsDone VStatus Done The core sets this bit when the vendor control access is done. This bit is cleared by the core when the application sets the New Register Request bit (bit 25).
26	RO	0x0	VStsBsy VStatus Busy The core sets this bit when the vendor control access is in progress and clears this bit when done.
25	RWSC	0x0	NewRegReq New Register Request The application sets this bit for a new vendor control access.
24:23	RO	0x0	reserved
22	RW	0x0	RegWr Register Write Set this bit for register writes, and clear it for register reads.
21:16	RW	0x00	RegAddr Register Address The 6-bit PHY register address for immediate PHY Register Set access. Set to 6'h2F for Extended PHY Register Set access.

Bit	Attr	Reset Value	Description
15:8	RW	0x00	VCtrl UTMI+ Vendor Control Register Address The 4-bit register address a vendor defined 4-bit parallel output bus. Bits 11:8 of this field are placed on utmi_vcontrol[3:0]. ULPI Extended Register Address (ExtRegAddr) The 6-bit PHY extended register address.
7:0	RW	0x00	RegData Register Data Contains the write data for register write. Read data for register read, valid when VStatus Done is set.

USBOTG_GGPIO

Address: Operational Base + offset (0x0038)

General Purpose Input/Output Register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	GPO General Purpose Output This field is driven as an output from the core, gp_o[15:0]. The application can program this field to determine the corresponding value on the gp_o[15:0] output.
15:0	RO	0x0000	GPI General Purpose Input This field's read value reflects the gp_i[15:0] core input value.

USBOTG_GUID

Address: Operational Base + offset (0x003c)

User ID Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	UserID Application-programmable ID field.

USBOTG_GSNPSID

Address: Operational Base + offset (0x0040)

Core ID Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00004f54	CoreID Release number of the core being used

USBOTG_GHWCFG1

Address: Operational Base + offset (0x0044)

User HW Config1 Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	<p>epdir Endpoint Direction This 32-bit field uses two bits per endpoint to determine the endpoint direction.</p> <p>Endpoint Bits [31:30]: Endpoint 15 direction Bits [29:28]: Endpoint 14 direction ... Bits [3:2]: Endpoint 1 direction Bits[1:0]: Endpoint 0 direction (always BIDIR) Direction 2'b00: BIDIR (IN and OUT) endpoint 2'b01: IN endpoint 2'b10: OUT endpoint 2'b11: Reserved</p>

USBOTG_GHWCFG2

Address: Operational Base + offset (0x0048)

User HW Config2 Register

Bit	Attr	Reset Value	Description
31	RO	0x0	OTG_ENABLE_IC_USB IC_USB mode specified for mode of operation (parameter OTG_ENABLE_IC_USB). To choose IC_USB_MODE, both OTG_FSPHY_INTERFACE and OTG_ENABLE_IC_USB must be 1.
30:26	RO	0x00	TknQDepth Device Mode IN Token Sequence Learning Queue Depth Range: 0-30
25:24	RO	0x0	PTxQDepth Host Mode Periodic Request Queue Depth 2'b00: 2 2'b01: 4 2'b10: 8 Others: Reserved

Bit	Attr	Reset Value	Description
23:22	RO	0x0	NPTxQDepth Non-periodic Request Queue Depth 2'b00: 2 2'b01: 4 2'b10: 8 Others: Reserved
21	RO	0x0	reserved
20	RO	0x0	MultiProcIntrpt Multi Processor Interrupt Enabled 1'b0: No 1'b1: Yes
19	RO	0x0	DynFifoSizing Dynamic FIFO Sizing Enabled 1'b0: No 1'b1: Yes
18	RO	0x0	PerioSupport Periodic OUT Channels Supported in Host Mode 1'b0: No 1'b1: Yes
17:14	RO	0x0	NumHstChnl Number of Host Channels Indicates the number of host channels supported by the core in Host mode. The range of this field is 0-15: 0 specifies 1 channel, 15 specifies 16 channels.
13:10	RO	0x0	NumDevEps Number of Device Endpoints Indicates the number of device endpoints supported by the core in Device mode in addition to control endpoint 0. The range of this field is 1-15.
9:8	RO	0x0	FSPhyType Full-Speed PHY Interface Type 2'b00: Full-speed interface not supported 2'b01: Dedicated full-speed interface 2'b10: FS pins shared with UTMI+ pins 2'b11: FS pins shared with ULPI pins
7:6	RO	0x0	HSPhyType High-Speed PHY Interface Type 2'b00: High-Speed interface not supported 2'b01: UTMI+ 2'b10: ULPI 2'b11: UTMI+ and ULPI

Bit	Attr	Reset Value	Description
5	RO	0x0	SingPnt Point-to-Point 1'b0: Multi-point application (hub and split support) 1'b1: Single-point application (no hub and no split support)
4:3	RO	0x0	OtgArch Architecture 2'b00: Slave-Only 2'b01: External DMA 2'b10: Internal DMA Others: Reserved
2:0	RO	0x0	OtgMode Mode of Operation 3'b000: HNP- and SRP-Capable OTG (Host and Device) 3'b001: SRP-Capable OTG (Host and Device) 3'b010: Non-HNP and Non-SRP Capable OTG (Host and Device) 3'b011: SRP-Capable Device 3'b100: Non-OTG Device 3'b101: SRP-Capable Host 3'b110: Non-OTG Host Others: Reserved

USBOTG_GHWCFG4

Address: Operational Base + offset (0x0050)

User HW Config4 Register

Bit	Attr	Reset Value	Description
31	RO	0x0	SGDMA Scatter/Gather DMA 1'b1: Dynamic configuration
30	RO	0x0	SGDMACon Scatter/Gather DMA configuration 1'b0: Non-Scatter/Gather DMA configuration 1'b1: Scatter/Gather DMA configuration

Bit	Attr	Reset Value	Description
29:26	RO	0x0	INEps Number of Device Mode IN Endpoints Including Control Endpoint Range 0 -15 0:1 IN Endpoint 1:2 IN Endpoints 15:16 IN Endpoints
25	RW	0x0	DedFifoMode Enable Dedicated Transmit FIFO for device IN Endpoints 1'b0: Dedicated Transmit FIFO Operation not enabled. 1'b1: Dedicated Transmit FIFO Operation enabled.
24	RW	0x0	SessEndFltr session_end Filter Enabled 1'b0: No filter 1'b1: Filter
23	RW	0x0	BValidFltr "b_valid" Filter Enabled 1'b0: No filter 1'b1: Filter
22	RO	0x0	AValidFltr "a_valid" Filter Enabled 1'b0: No filter 1'b1: Filter
21	RO	0x0	VBusValidFltr "vbus_valid" Filter Enabled 1'b0: No filter 1'b1: Filter
20	RO	0x0	IddgFltr "iddig" Filter Enable 1'b0: No filter 1'b1: Filter
19:16	RO	0x0	NumCtlEps Number of Device Mode Control Endpoints in Addition to Endpoint Range: 0-15

Bit	Attr	Reset Value	Description
15:14	RO	0x0	<p>PhyDataWidth UTMI+ PHY/ULPI-to-Internal UTMI+ Wrapper Data Width</p> <p>When a ULPI PHY is used, an internal wrapper converts ULPI to UTMI+.</p> <p>2'b00: 8 bits 2'b01: 16 bits 2'b10: 8/16 bits, software selectable Others: Reserved</p>
13:7	RO	0x0	reserved
6	RO	0x0	<p>EnHiber Enable Hibernation</p> <p>1'b0: Hibernation feature not enabled 1'b1: Hibernation feature enabled</p>
5	RO	0x0	<p>AhbFreq Minimum AHB Frequency Less Than 60 MHz</p> <p>1'b0: No 1'b1: Yes</p>
4	RO	0x0	<p>EnParPwrDown Enable Partial Power Down</p> <p>1'b0: Partial Power Down Not Enabled 1'b1: Partial Power Down Enabled</p>
3:0	RO	0x0	<p>NumDevPerioEps Number of Device Mode Periodic IN Endpoints</p> <p>Range: 0-15</p>

USBOTG_GPWRDN

Address: Operational Base + offset (0x0058)

Global Power Down Register

Bit	Attr	Reset Value	Description
31:29	RO	0x0	reserved

Bit	Attr	Reset Value	Description
28:24	RO	0x00	MultValIdBC Multi Valued ID pin Battery Charger ACA inputs in the following order: Bit 26 - rid_float. Bit 25 - rid_gnd Bit 24 - rid_a Bit 23 - rid_b Bit 22 - rid_c These bits are present only if OTG_BC_SUPPORT = 1. Otherwise, these bits are reserved and will read 5'h0.
23	W1C	0x0	ADPInt ADP Interrupt This bit is set whenever there is a ADP event.
22	RO	0x0	BSessVld B Session Valid This field reflects the B session valid status signal from the PHY. 1'b0: B-Valid is 0. 1'b1: B-Valid is 1. This bit is valid only when GPWRDN.PMUActv is 1.
21	RO	0x0	IDDIG This bit indicates the status of the signal IDDIG. The application must read this bit after receiving GPWRDN.StsChngInt and decode based on the previous value stored by the application. Indicates the current mode. 1'b1: Device mode 1'b0: Host mode This bit is valid only when GPWRDN.PMUActv is 1.
20:19	RO	0x0	LineState This field indicates the current linestate on USB as seen by the PMU module. 2'b00: DM = 0, DP = 0. 2'b01: DM = 0, DP = 1. 2'b10: DM = 1, DP = 0. 2'b11: Not-defined. This bit is valid only when GPWRDN.PMUActv is 1.

Bit	Attr	Reset Value	Description
18	RW	0x0	StsChngIntMsk Mask For StsChng Interrupt
17	W1C	0x0	StsChngInt This field indicates a status change in either the IDDIG or BSessVld signal. 1'b0: No Status change 1'b1: status change detected After receiving this interrupt the application should read the GPWRDN register and interpret the change in IDDIG or BSesVld with respect to the previous value stored by the application.
16	RW	0x0	SRPDetectMsk Mask For SRPDetect Interrupt
15	W1C	0x0	SRPDetect This field indicates that SRP has been detected by the PMU. This field generates an interrupt. After detecting SRP during hibernation the application should not restore the core. The application should get into the initialization process. 1'b0: SRP not detected 1'b1: SRP detected
14	RW	0x0	ConnDetMsk Mask for ConnectDet interrupt This bit is valid only when OTG_EN_PWROPT = 2.
13	W1C	0x0	ConnectDet This field indicates that a new connect has been detected 1'b0: Connect not detected 1'b1: Connect detected This bit is valid only when OTG_EN_PWROPT = 2.
12	RW	0x0	DisconnectDetectMsk Mask For DisconnectDetect Interrupt This bit is valid only when OTG_EN_PWROPT = 2.

Bit	Attr	Reset Value	Description
11	W1C	0x0	<p>DisconnectDetect</p> <p>This field indicates that Disconnect has been detected by the PMU. This field generates an interrupt. After detecting disconnect during hibernation the application must not restore the core, but instead start the initialization process.</p> <p>1'b0: Disconnect not detected 1'b1: Disconnect detected</p> <p>This bit is valid only when OTG_EN_PWRROPT = 2.</p>
10	RW	0x0	<p>ResetDetMsk</p> <p>Mask For ResetDetected interrupt. This bit is valid only when OTG_EN_PWRROPT = 2.</p>
9	W1C	0x0	<p>ResetDetected</p> <p>This field indicates that Reset has been detected by the PMU module. This field generates an interrupt.</p> <p>1'b0: Reset Not Detected 1'b1: Reset Detected</p> <p>This bit is valid only when OTG_EN_PWRROPT = 2.</p>
8	RW	0x0	<p>LineStageChangeMsk</p> <p>Mask For LineStateChange interrupt</p> <p>This bit is valid only when OTG_EN_PWRROPT = 2.</p>
7	W1C	0x0	<p>LnStsChng</p> <p>Line State Change</p> <p>This interrupt is asserted when there is a Linestate Change detected by the PMU. The application should read GPWRDN.Linestate to determine the current linestate on USB.</p> <p>1'b0: No LineState change on USB 1'b1: LineState change on USB</p> <p>This bit is valid only when GPWRDN.PMUActv is 1. This bit is valid only when OTG_EN_PWRROPT = 2.</p>

Bit	Attr	Reset Value	Description
6	RW	0x0	<p>DisableVBUS</p> <p>The application should program this bit if HPRT0.PrtPwr was programmed to 0 before entering Hibernation. This is to indicate PMU whether session was ended before entering Hibernation.</p> <p>1'b0: HPRT0.PrtPwr was not programmed to 0. 1'b1: HPRT0.PrtPwr was programmed to 0.</p>
5	RW	0x0	<p>PwrDnSwtch</p> <p>Power Down Switch</p> <p>This bit indicates to the OTG core VDD switch is in ON/OFF state</p> <p>1'b0: OTG is in ON state 1'b1: OTG is in OFF state</p> <p>Note: This bit must not be written to during normal mode of operation.</p>
4	RW	0x0	<p>PwrDnRst_n</p> <p>Power Down ResetN</p> <p>The application must program this bit to reset the OTG core during the Hibernation exit process or during ADP when powering up the core (in case the OTG core was powered off during ADP process).</p> <p>1'b1: otg is in normal operation 1'b0: reset otg</p> <p>Note: This bit must not be written to during normal mode of operation.</p>
3	RW	0x0	<p>PwrDnClmp</p> <p>Power Down Clamp</p> <p>The application must program this bit to enable or disable the clamps to all the outputs of the OTG core module to prevent the corruption of other active logic.</p> <p>1'b0: Disable PMU power clamp 1'b1: Enable PMU power clamp</p>

Bit	Attr	Reset Value	Description
2	RW	0x0	<p>Restore</p> <p>The application should program this bit to enable or disable restore mode from the PMU module.</p> <p>1'b0: OTG in normal mode of operation 1'b1: OTG in restore mode</p> <p>Note: This bit must not be written to during normal mode of operation. This bit is valid only when OTG_EN_PWR_OPT = 2.</p>
1	RW	0x0	<p>PMUActv</p> <p>PMU Active</p> <p>This bit is to enable or disable the PMU logic.</p> <p>1'b0: Disable PMU module 1'b1: Enable PMU module</p> <p>Note: This bit must not be written to during normal mode of operation.</p>
0	RW	0x0	<p>PMUIntSel</p> <p>PMU Interrupt Select</p> <p>When the hibernation functionality is selected using the configuration option OTG_EN_PWR_OPT = 2, a write to this bit with 1'b1 enables the PMU to generate interrupts to the application. During this state all interrupts from the core module are blocked to the application. Note: This bit must be set to 1'b1 before the core is put into hibernation</p> <p>1'b0: Internal otg_core interrupt is selected 1'b1: the external otg_pmu interrupt is selected</p> <p>Note: This bit must not be written to during normal mode of operation.</p>

USBOTG_GDFIFO CFG

Address: Operational Base + offset (0x005c)

Global DFIFO Software Config Register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>EPInfoBaseAddr</p> <p>This field provides the start address of the EP info controller.</p>

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	GDFIFOcfg This field is for dynamic programming of the DFIFO Size. This value takes effect only when the application programs a non zero value to this register. The core does not have any corrective logic if the FIFO sizes are programmed incorrectly.

USBOTG_GADPCTL

Address: Operational Base + offset (0x0060)

ADP Timer, Control and Status Register

Bit	Attr	Reset Value	Description
31:29	RO	0x0	reserved
28:27	RWSC	0x0	AR Access Request 2'b00 Read/Write Valid (updated by the core) 2'b01 Read 2'b10 Write 2'b11 Reserved
26	RW	0x0	AdpTmoutMsk ADP Timeout Interrupt Mask When this bit is set, it unmasks the interrupt because of AdpTmoutInt. This bit is valid only if OTG_Ver = 1'b1(GOTGCTL[20]).
25	RW	0x0	AdpSnsIntMsk ADP Sense Interrupt Mask When this bit is set, it unmasks the interrupt due to AdpSnsInt. This bit is valid only if OTG_Ver = 1'b1(GOTGCTL[20]).
24	RW	0x0	AdpPrbIntMsk ADP Probe Interrupt Mask When this bit is set, it unmasks the interrupt due to AdpPrbInt. This bit is valid only if OTG_Ver = 1'b1(GOTGCTL[20]).

Bit	Attr	Reset Value	Description
23	W1C	0x0	<p>AdpTmoutInt ADP Timeout Interrupt This bit is relevant only for an ADP probe. When this bit is set, it means that the ramp time has completed (GADPCTL.RTIM has reached its terminal value of 0x7FF). This is a debug feature that allows software to read the ramp time after each cycle. This bit is valid only if OTG_Ver = 1'b1.</p>
22	W1C	0x0	<p>AdpSnsInt ADP Sense Interrupt When this bit is set, it means that the VBUS voltage is greater than VadpSns value or VadpPrb is reached. This bit is valid only if OTG_Ver = 1'b1 (GOTGCTL[20]).</p>
21	W1C	0x0	<p>AdpPrbInt ADP Probe Interrupt When this bit is set, it means that the VBUS voltage is greater than VadpPrb or VadpPrb is reached. This bit is valid only if OTG_Ver = 1'b1 (GOTGCTL[20]).</p>
20	RW	0x0	<p>ADPEN ADP Enable When set, the core performs either ADP probing or sensing based on EnaPrb or EnaSns. This bit is valid only if OTG_Ver = 1'b1 (GOTGCTL[20]).</p>
19	RWSC	0x0	<p>ADPRes ADP Reset When set, ADP controller is reset. This bit is auto-cleared after the reset procedure is complete in ADP controller. This bit is valid only if OTG_Ver = 1'b1 (GOTGCTL[20]).</p>
18	RW	0x0	<p>EnaSns Enable Sense When programmed to 1'b1, the core performs a sense operation. This bit is valid only if OTG_Ver = 1'b1 (GOTGCTL[20]).</p>

Bit	Attr	Reset Value	Description
17	RW	0x0	<p>EnaPrb Enable Probe</p> <p>When programmed to 1'b1, the core performs a probe operation. This bit is valid only if OTG_Ver = 1'b1 (GOTGCTL[20]).</p>
16:6	RO	0x000	<p>RTIM RAMP TIME</p> <p>These bits capture the latest time it took for VBUS to ramp from VADP_SINK to VADP_PRB. The bits are defined in units of 32 kHz clock cycles as follows:</p> <ul style="list-style-type: none"> 0x000 - 1 cycles 0x001 - 2 cycles 0x002 - 3 cycles and so on till 0x7FF - 2048 cycles <p>A time of 1024 cycles at 32 kHz corresponds to a time of 32 msec.</p> <p>(Note for scaledown ramp_timeout = prb_delta == 2'b00 => 200 cycles prb_delta == 2'b01 => 100 cycles prb_delta == 2'b01 => 50 cycles prb_delta == 2'b01 => 25 cycles.)</p>
5:4	RW	0x0	<p>PrbPer Probe Period</p> <p>These bits sets the TadpPrd as follows:</p> <ul style="list-style-type: none"> 2'b00 - 0.625 to 0.925 sec (typical 0.775 sec) 2'b01 - 1.25 to 1.85 sec (typical 1.55 sec) 2'b10 - 1.9 to 2.6 sec (typical 2.275 sec) 2'b11 - Reserved <p>(PRB_PER is also scaledown prb_per== 2'b00 => 400 ADP clocks prb_per== 2'b01 => 600 ADP clocks prb_per== 2'b10 => 800 ADP clocks prb_per==2'b11 => 1000 ADP clocks)</p>

Bit	Attr	Reset Value	Description
3:2	RW	0x0	<p>PrbDelta Probe Delta</p> <p>These bits set the resolution for RTIM value. The bits are defined in units of 32 kHz clock cycles as follows:</p> <ul style="list-style-type: none"> 2'b00 - 1 cycles 2'b01 - 2 cycles 2'b10 - 3 cycles 2'b11 - 4 cycles <p>For example if this value is chosen to 2'b01, it means that RTIM increments for every three 32Khz clock cycles.</p>
1:0	RW	0x0	<p>PrbDschg Probe Discharge</p> <p>These bits set the times for TadpDschg. These bits are defined as follows:</p> <ul style="list-style-type: none"> 2'b00 4 msec (Scaledown 2 32Khz clock cycles) 2'b01 8 msec (Scaledown 4 32Khz clock cycles) 2'b10 16 msec (Scaledown 8 32Khz clock cycles) 2'b11 32 msec (Scaledown 16 32Khz clock cycles)

USBOTG_HPTXFSIZ

Address: Operational Base + offset (0x0100)

Host Periodic Transmit FIFO Size Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>PTxFSize Host Periodic TxFIFO Depth This value is in terms of 32-bit words. Minimum value is 16 Maximum value is 32,768 The power-on reset value of this register is specified as the Largest Host Mode Periodic Tx Data FIFO Depth (parameter OTG_TX_HPERIO_DFIFO_DEPTH). If Enable Dynamic FIFO Sizing? was deselected (parameter OTG_DFIFO_DYNAMIC = 0), these flops are optimized, and reads return the power-on value. If Enable Dynamic FIFO Sizing? was selected (parameter OTG_DFIFO_DYNAMIC = 1), you can write a new value in this field. Programmed values must not exceed the power-on value .</p>
15:0	RW	0x0000	<p>PTxFSAddr Host Periodic TxFIFO Start Address The power-on reset value of this register is the sum of the Largest Rx Data FIFO Depth and Largest Non-periodic Tx Data FIFO Depth specified. These parameters are: In shared FIFO operation: OTG_RX_DFIFO_DEPTH + OTG_TX_NPERIO_DFIFO_DEPTH. In dedicated FIFO mode: OTG_RX_DFIFO_DEPTH + OTG_TX_HNPERIO_DFIFO_DEPTH. If Enable Dynamic FIFO Sizing? was deselected (parameter OTG_DFIFO_DYNAMIC = 0), these flops are optimized, and reads return the power-on value. If Enable Dynamic FIFO Sizing? was selected (parameter OTG_DFIFO_DYNAMIC = 1), you can write a new value in this field. Programmed values must not exceed the power-on value.</p>

USBOTG_DIEPTXF_n

Address: Operational Base + offset (0x0104 + 0x4 * n) 0≤n≤14

Device Periodic Transmit FIFO-n Size Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:16	RW	0x0000	<p>INEP1TxFDep IN Endpoint TxFIFO Depth This value is in terms of 32-bit words. Minimum value is 16 Maximum value is 32,768 The power-on reset value of this register is specified as the Largest IN Endpoint FIFO number Depth (parameter OTG_TX_DINEP_DFIFO_DEPTH_n)($0 < n \leq 15$). If Enable Dynamic FIFO Sizing? was deselected (parameter OTG_DFIFO_DYNAMIC = 0), these flops are optimized, and reads return the power-on value. If Enable Dynamic FIFO Sizing? was selected (parameter OTG_DFIFO_DYNAMIC = 1), you can write a new value in this field. Programmed values must not exceed the power-on value .</p>
15:0	RW	0x0000	<p>INEP1TxFStAddr IN Endpoint FIFO1 Transmit RAM Start Address This field contains the memory start address for IN endpoint Transmit FIFOOn ($0 < n \leq 15$). The power-on reset value of this register is specified as the Largest Rx Data FIFO Depth (parameter OTG_RX_DFIFO_DEPTH). OTG_RX_DFIFO_DEPTH + SUM 0 to n-1 (OTG_DINEP_TXFIFO_DEPTH_n) For example start address of IN endpoint FIFO 1 is OTG_RX_DFIFO_DEPTH + OTG_DINEP_TXFIFO_DEPTH_0. The start address of IN endpoint FIFO 2 is OTG_RX_DFIFO_DEPTH + OTG_DINEP_TXFIFO_DEPTH_0 + OTG_DINEP_TXFIFO_DEPTH_1. If Enable Dynamic FIFO Sizing? was deselected (parameter OTG_DFIFO_DYNAMIC = 0), these flops are optimized, and reads return the power-on value. If Enable Dynamic FIFO Sizing? was selected (parameter OTG_DFIFO_DYNAMIC = 1), and you have programmed a new value for RxFIFO depth, you can write that value in this field. Programmed values must not exceed the power-on value set .</p>

USBOTG_HCFG

Address: Operational Base + offset (0x0400)

Host Configuration Register

Bit	Attr	Reset Value	Description
31:27	RO	0x0	reserved
26	RW	0x0	PerSchedEna Enable Periodic Scheduling Applicable in Scatter/Gather DMA mode only. Enables periodic scheduling within the core. Initially, the bit is reset. The core will not process any periodic channels. As soon as this bit is set, the core will get ready to start scheduling periodic channels and sets HCFG.PerSchedStat. The setting of HCFG.PerSchedStat indicates the core has enabled periodic scheduling. Once HCFG.PerSchedEna is set, the application is not supposed to again reset the bit unless HCFG.PerSchedStat is set. As soon as this bit is reset, the core will get ready to stop scheduling periodic channels and resets HCFG.PerSchedStat. In non Scatter/Gather DMA mode, this bit is reserved.
25:24	RW	0x0	FrListEn Frame List Entries The value in the register specifies the number of entries in the Frame list. This field is valid only in Scatter/Gather DMA mode.

Bit	Attr	Reset Value	Description
23	RW	0x0	<p>DescDMA</p> <p>Enable Scatter/gather DMA in Host mode</p> <p>When the Scatter/Gather DMA option selected during configuration of the RTL, the application can set this bit during initialization to enable the Scatter/Gather DMA operation.</p> <p>NOTE: This bit must be modified only once after a reset. The following combinations are available for programming:</p> <ul style="list-style-type: none"> GAHBCFG.DMAEn=0, HCFG.DescDMA=0 => Slave mode GAHBCFG.DMAEn=0, HCFG.DescDMA=1 => Invalid GAHBCFG.DMAEn=1, HCFG.DescDMA=0 => Buffered DMA mode GAHBCFG.DMAEn=1, HCFG.DescDMA=1 => Scatter/Gather DMA mode <p>In non Scatter/Gather DMA mode, this bit is reserved.</p>
22:16	RO	0x0	reserved
15:8	RW	0x00	<p>ResValid</p> <p>Resume Validation Period</p> <p>This field is effective only when HCFG.Ena32KHzS is set. It controls the resume period when the core resumes from suspend. The core counts the ResValid number of clock cycles to detect a valid resume when this is set.</p>
7	RW	0x0	<p>Ena32KHzS</p> <p>Enable 32-KHz Suspend Mode</p> <p>This bit can only be set if the USB 1.1 Full-Speed Serial Transceiver Interface has been selected. If USB 1.1 Full-Speed Serial Transceiver Interface has not been selected, this bit must be zero. When the USB 1.1 Full-Speed Serial Transceiver Interface is chosen and this bit is set, the core expects the 48-MHz PHY clock to be switched to 32 KHz during a suspend.</p>
6:3	RO	0x0	reserved

Bit	Attr	Reset Value	Description
2	RW	0x0	<p>FSLSSupp FS- and LS-Only Support The application uses this bit to control the core enumeration speed. Using this bit, the application can make the core enumerate as a FS host, even if the connected device supports HS traffic. Do not make changes to this field after initial programming.</p> <p>1'b0: HS/FS/LS, based on the maximum speed supported by the connected device 1'b1: FS/LS-only, even if the connected device can support HS</p>
1:0	RW	0x0	<p>FSLSPclkSel FS/LS PHY Clock Select 2'b00: PHY clock is running at 30/60 MHz 2'b01: PHY clock is running at 48 MHz Others: Reserved</p>

USBOTG_HFIR

Address: Operational Base + offset (0x0404)

Host Frame Interval Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	<p>FrInt Frame Interval The value that the application programs to this field specifies the interval between two consecutive SOFs (FS) or micro-SOFs (HS) or Keep-Alive tokens (HS). This field contains the number of PHY clocks that constitute the required frame interval. The default value set in this field for a FS operation when the PHY clock frequency is 60 MHz. The application can write a value to this register only after the Port Enable bit of the Host Port Control and Status register (HPRT.PrtEnaPort) has been set. If no value is programmed, the core calculates the value based on the PHY clock specified in the FS/LS PHY Clock Select field of the Host Configuration register (HCFG.FSLSPclkSel). Do not change the value of this field after the initial configuration.</p> <p>125 us * (PHY clock frequency for HS) 1 ms * (PHY clock frequency for FS/LS)</p>

USBOTG_HFNUM

Address: Operational Base + offset (0x0408)

Host Frame Number/Frame Time Remaining Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	<p>FrRem Frame Time Remaining Indicates the amount of time remaining in the current microframe (HS) or frame (FS/LS), in terms of PHY clocks. This field decrements on each PHY clock. When it reaches zero, this field is reloaded with the value in the Frame Interval register and a new SOF is transmitted on the USB.</p>
15:0	RO	0xffff	<p>FrNum Frame Number This field increments when a new SOF is transmitted on the USB, and is reset to 0 when it reaches 16'h3FFF. This field is writable only if Remove Optional Features? was not selected (OTG_RM_OTG_FEATURES = 0). Otherwise, reads return the frame number value.</p>

USBOTG_HPTXSTS

Address: Operational Base + offset (0x0410)

Host Periodic Transmit FIFO/Queue Status Register

Bit	Attr	Reset Value	Description
31:24	RO	0x00	<p>PTxQTop Top of the Periodic Transmit Request Queue This indicates the entry in the Periodic Tx Request Queue that is currently being processes by the MAC. This register is used for debugging.</p> <p>Bit [31]: Odd/Even (micro)frame 1'b0: send in even (micro)frame 1'b1: send in odd (micro)frame Bits [30:27]: Channel/endpoint number Bits [26:25]: Type 2'b00: IN/OUT 2'b01: Zero-length packet 2'b10: CSPLIT 2'b11: Disable channel command Bit [24]: Terminate (last entry for the selected channel/endpoint)</p>
23:16	RO	0x00	<p>PTxQSpAvail Periodic Transmit Request Queue Space Available Indicates the number of free locations available to be written in the Periodic Transmit Request Queue. This queue holds both IN and OUT requests.</p> <p>8'h0: Periodic Transmit Request Queue is full 8'h1: 1 location available 8'h2: 2 locations available n: n locations available (0 <=n <= 16) Others: Reserved</p>

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	<p>PTxFSpAvail Periodic Transmit Data FIFO Space Available Indicates the number of free locations available to be written to in the Periodic TxFIFO. Values are in terms of 32-bit words</p> <ul style="list-style-type: none"> . 16'h0: Periodic TxFIFO is full . 16'h1: 1 word available . 16'h2: 2 words available . 16'hn: n words available (where 0 . n . 32,768) . 16'h8000: 32,768 words available . Others: Reserved

USBOTG_HAIT

Address: Operational Base + offset (0x0414)

Host All Channels Interrupt Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RO	0x0000	<p>HAI NT</p> <p>Channel Interrupts</p> <p>One bit per channel: Bit 0 for Channel 0, bit 15 for Channel 15</p>

USBOTG_HAITMSK

Address: Operational Base + offset (0x0418)

Host All Channels Interrupt Mask Register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	<p>HAI NTMsk</p> <p>Channel Interrupt Mask</p> <p>One bit per channel: Bit 0 for channel 0, bit 15 for channel 15</p>

USBOTG_HPRT

Address: Operational Base + offset (0x0440)

Host Port Control and Status Register

Bit	Attr	Reset Value	Description
31:19	RO	0x0	reserved

Bit	Attr	Reset Value	Description
18:17	RO	0x0	<p>PrtSpd Port Speed Indicates the speed of the device attached to this port.</p> <p>2'b00: High speed 2'b01: Full speed 2'b10: Low speed 2'b11: Reserved</p>
16:13	RW	0x0	<p>PrtTstCtl Port Test Control The application writes a nonzero value to this field to put the port into a Test mode, and the corresponding pattern is signaled on the port.</p> <p>4'b0000: Test mode disabled 4'b0001: Test_J mode 4'b0010: Test_K mode 4'b0011: Test_SE0_NAK mode 4'b0100: Test_Packet mode 4'b0101: Test_Force_Enable Others: Reserved</p>
12	RWSC	0x0	<p>PrtPwr Port Power The application uses this field to control power to this port (write 1'b1 to set to 1'b1 and write 1'b0 to set to 1'b0), and the core can clear this bit on an over current condition.</p> <p>1'b0: Power off 1'b1: Power on</p>
11:10	RO	0x0	<p>PrtLnsts Port Line Status Indicates the current logic level USB data lines</p> <p>Bit [10]: Logic level of D+ Bit [11]: Logic level of D</p>
9	RO	0x0	reserved

Bit	Attr	Reset Value	Description
8	RW	0x0	<p>PrtRst Port Reset</p> <p>When the application sets this bit, a reset sequence is started on this port. The application must time the reset period and clear this bit after the reset sequence is complete.</p> <p>1'b0: Port not in reset 1'b1: Port in reset</p> <p>To start a reset on the port, the application must leave this bit set for at least the minimum duration mentioned below, as specified in the USB 2.0 specification, Section 7.1.7.5. The application can leave it set for another 10 ms in addition to the required minimum duration, before clearing the bit, even though there is no maximum limit set by the USB standard.</p> <p>High speed: 50 ms Full speed/Low speed: 10 ms</p>
7	RWSC	0x0	<p>PrtSusp Port Suspend</p> <p>The application sets this bit to put this port in Suspend mode. The core only stops sending SOFs when this is set. To stop the PHY clock, the application must set the Port Clock Stop bit, which asserts the suspend input pin of the PHY.</p> <p>The read value of this bit reflects the current suspend status of the port. This bit is cleared by the core after a remote wakeup signal is detected or the application sets the Port Reset bit or Port Resume bit in this register or the Resume/Remote Wakeup Detected Interrupt bit or Disconnect Detected Interrupt bit in the Core Interrupt register (GINTSTS.WkUpInt or GINTSTS.DisconnInt, respectively).</p> <p>1'b0: Port not in Suspend mode 1'b1: Port in Suspend mode</p>

Bit	Attr	Reset Value	Description
6	RWSC	0x0	<p>PrtRes Port Resume</p> <p>The application sets this bit to drive resume signaling on the port. The core continues to drive the resume signal until the application clears this bit.</p> <p>If the core detects a USB remote wakeup sequence, as indicated by the Port Resume/Remote Wakeup Detected Interrupt bit of the Core Interrupt register (GINTSTS.WkUpInt), the core starts driving resume signaling without application intervention and clears this bit when it detects a disconnect condition. The read value of this bit indicates whether the core is currently driving resume signaling.</p> <p>1'b0: No resume driven 1'b1: Resume driven</p> <p>When LPM is enabled and the core is in the L1 (Sleep) state, setting this bit results in the following behavior:</p> <p>The core continues to drive the resume signal until a pre-determined time specified in the GLPMCFG.HIRD_Thres[3:0] field.</p> <p>If the core detects a USB remote wakeup sequence, as indicated by the Port L1 Resume/Remote L1 Wakeup Detected Interrupt bit of the Core Interrupt register (GINTSTS.L1WkUpInt), the core starts driving resume signaling without application intervention and clears this bit at the end of the resume. The read value of this bit indicates whether the core is currently driving resume signaling.</p> <p>1'b0: No resume driven 1'b1: Resume driven</p>
5	W1C	0x0	<p>PrtOvrCurrChng Port Overcurrent Change</p> <p>The core sets this bit when the status of the Port Overcurrent Active bit (bit 4) in this register changes.</p>

Bit	Attr	Reset Value	Description
4	RO	0x0	PrtOvrCurrAct Port Overcurrent Active Indicates the overcurrent condition of the port. 1'b0: No overcurrent condition 1'b1: Overcurrent condition
3	W1C	0x0	PrtEnChng Port Enable/Disable Change The core sets this bit when the status of the Port Enable bit [2] of this register changes.
2	W1C	0x0	PrtEna Port Enable A port is enabled only by the core after a reset sequence, and is disabled by an overcurrent condition, a disconnect condition, or by the application clearing this bit. The application cannot set this bit by a register write. It can only clear it to disable the port. This bit does not trigger any interrupt to the application. 1'b0: Port disabled 1'b1: Port enabled
1	W1C	0x0	PrtConnDet Port Connect Detected The core sets this bit when a device connection is detected to trigger an interrupt to the application using the Host Port Interrupt bit of the Core Interrupt register (GINTSTS.PrtInt). The application must write a 1 to this bit to clear the interrupt.
0	RO	0x0	PrtConnSts Port Connect Status 0: No device is attached to the port. 1: A device is attached to the port.

USBOTG_HCCHARn

Address: Operational Base + offset (0x0500 + 0x20 * n) $0 \leq n \leq 15$
 Host Channel-n Characteristics Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31	RWSC	0x0	<p>ChEna Channel Enable When Scatter/Gather mode is enabled 1'b0: Indicates that the descriptor structure is not yet ready. 1'b1: Indicates that the descriptor structure and data buffer with data is setup and this channel can access the descriptor.</p> <p>When Scatter/Gather mode is disabled, This field is set by the application and cleared by the OTG host. 1'b0: Channel disabled 1'b1: Channel enabled</p>
30	RWSC	0x0	<p>ChDis Channel Disable The application sets this bit to stop transmitting/receiving data on a channel, even before the transfer for that channel is complete. The application must wait for the Channel Disabled interrupt before treating the channel as disabled.</p>
29	RW	0x0	<p>OddFrm Odd Frame This field is set (reset) by the application to indicate that the OTG host must perform a transfer in an odd (micro)frame. This field is applicable for only periodic (isochronous and interrupt) transactions. 1'b0: Even (micro)frame 1'b1: Odd (micro)frame This field is not applicable for Scatter/Gather DMA mode and need not be programmed by the application and is ignored by the core.</p>
28:22	RW	0x00	<p>DevAddr Device Address This field selects the specific device serving as the data source or sink.</p>

Bit	Attr	Reset Value	Description
21:20	RW	0x0	<p>MC_EC Multi Count (MC) / Error Count (EC) When the Split Enable bit of the Host Channel-n Split Control register (HCSPLTn.Spltna) is reset (1'b0), this field indicates to the host the number of transactions that must be executed per microframe for this periodic endpoint. For non periodic transfers, this field is used only in DMA mode, and specifies the number packets to be fetched for this channel before the internal DMA engine changes arbitration.</p> <p>2'b00: Reserved This field yields undefined results. 2'b01: 1 transaction 2'b10: 2 transactions to be issued for this endpoint per microframe 2'b11: 3 transactions to be issued for this endpoint per microframe</p> <p>When HCSPLTn.Spltna is set (1'b1), this field indicates the number of immediate retries to be performed for a periodic split transactions on transaction errors. This field must be set to at least 2'b01.</p>
19:18	RW	0x0	<p>EPType Endpoint Type Indicates the transfer type selected.</p> <p>2'b00: Control 2'b01: Isochronous 2'b10: Bulk 2'b11: Interrupt</p>
17	RW	0x0	<p>LSpdDev Low-Speed Device This field is set by the application to indicate that this channel is communicating to a low-speed device.</p>
16	RO	0x0	reserved
15	RW	0x0	<p>EPDir Endpoint Direction Indicates whether the transaction is IN or OUT.</p> <p>1'b0: OUT 1'b1: IN</p>

Bit	Attr	Reset Value	Description
14:11	RW	0x0	EPNum Endpoint Number Indicates the endpoint number on the device serving as the data source or sink.
10:0	RW	0x000	MPS Maximum Packet Size Indicates the maximum packet size of the associated endpoint.

USBOTG_HCSPLTn

Address: Operational Base + offset (0x0504 + 0x20 * n) $0 \leq n \leq 15$

Host Channel-n Split Control Register

Bit	Attr	Reset Value	Description
31	RW	0x0	SplitEna Split Enable The application sets this field to indicate that this channel is enabled to perform split transactions.
30:17	RO	0x0	reserved
16	RW	0x0	CompSplt Do Complete Split The application sets this field to request the OTG host to perform a complete split transaction.
15:14	RW	0x0	XactPos Transaction Position This field is used to determine whether to send all, first, middle, or last payloads with each OUT transaction. 2'b11: All. This is the entire data payload is of this transaction (which is less than or equal to 188 bytes). 2'b10: Begin. This is the first data payload of this transaction (which is larger than 188 bytes). 2'b00: Mid. This is the middle payload of this transaction (which is larger than 188bytes). 2'b01: End. This is the last payload of this transaction (which is larger than 188 bytes).
13:7	RW	0x00	HubAddr Hub Address This field holds the device address of the transaction translator's hub.

Bit	Attr	Reset Value	Description
6:1	RO	0x0	reserved
0	RW	0x0	PrtAddr Port Address This field is the port number of the recipient transaction translator.

USBOTG_HCINTn

Address: Operational Base + offset (0x0508 + 0x20 * n) 0≤n≤15

Host Channel-n Interrupt Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	W1C	0x0	DESC_LST_ROLLIntr Descriptor rollover interrupt This bit is valid only when Scatter/Gather DMA mode is enabled. The core sets this bit when the corresponding channel's descriptor list rolls over. For non Scatter/Gather DMA mode, this bit is reserved.
12	W1C	0x0	XCS_XACT_ERR Excessive Transaction Error This bit is valid only when Scatter/Gather DMA mode is enabled. The core sets this bit when 3 consecutive transaction errors occurred on the USB bus. XCS_XACT_ERR will not be generated for Isochronous channels. For non Scatter/Gather DMA mode, this bit is reserved.
11	W1C	0x0	BNAIntr BNA (Buffer Not Available) Interrupt This bit is valid only when Scatter/Gather DMA mode is enabled. The core generates this interrupt when the descriptor accessed is not ready for the Core to process. BNA will not be generated for Isochronous channels. For non Scatter/Gather DMA mode, this bit is reserved.
10	W1C	0x0	DataTglErr Data Toggle Error In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core.
9	W1C	0x0	FrmOvrn Frame Overrun In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core

Bit	Attr	Reset Value	Description
8	W1C	0x0	BblErr Babble Error In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core.
7	W1C	0x0	XactErr Transaction Error Indicates one of the following errors occurred on the USB: CRC check failure, Timeout, Bit stuff error, False EOP. In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core.
6	WO	0x0	NYET NYET Response Received Interrupt In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core.
5	W1C	0x0	ACK ACK Response Received/Transmitted Interrupt In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core.
4	W1C	0x0	NAK NAK Response Received Interrupt In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core.
3	W1C	0x0	STALL STALL Response Received Interrupt In Scatter/Gather DMA mode, the interrupt due to this bit is masked in the core.
2	W1C	0x0	AHBErr AHB Error This is generated only in DMA mode when there is an AHB error during AHB read/write. The application can read the corresponding channel's DMA address register to get the error address.

Bit	Attr	Reset Value	Description
1	W1C	0x0	ChHltd Channel Halted In non Scatter/Gather DMA mode, it indicates the transfer completed abnormally either because of any USB transaction error or in response to disable request by the application or because of a completed transfer. In Scatter/Gather DMA mode, this indicates that transfer completed due to any of the following: EOL being set in descriptor, AHB error, Excessive transaction errors, In response to disable request by the application, Babble, Stall, Buffer Not Available (BNA)
0	W1C	0x0	XferCompl Transfer Completed For Scatter/Gather DMA mode, it indicates that current descriptor processing got completed with IOC bit set in its descriptor. In non Scatter/Gather DMA mode, it indicates that Transfer completed normally without any errors.

USBOTG_HCINTMSKn

Address: Operational Base + offset (0x050c + 0x20 * n) 0≤n≤15

Host Channel-n Interrupt Mask Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RW	0x0	DESC_LST_ROLLIntrMsk Descriptor rollover interrupt Mask register This bit is valid only when Scatter/Gather DMA mode is enabled. In non Scatter/Gather DMA mode, this bit is reserved.
12	RO	0x0	reserved
11	RW	0x0	BNAIntrMsk BNA (Buffer Not Available) Interrupt mask register This bit is valid only when Scatter/Gather DMA mode is enabled. In non Scatter/Gather DMA mode, this bit is reserved.
10	RW	0x0	DataTglErrMsk Data Toggle Error Mask This bit is not applicable in Scatter/Gather DMA mode.

Bit	Attr	Reset Value	Description
9	RW	0x0	FrmOvrnMsk Frame Overrun Mask This bit is not applicable in Scatter/Gather DMA mode.
8	RW	0x0	BblErrMsk Babble Error Mask This bit is not applicable in Scatter/Gather DMA mode.
7	RW	0x0	XactErrMsk Transaction Error Mask This bit is not applicable in Scatter/Gather DMA mode
6	RW	0x0	NyetMsk NYET Response Received Interrupt Mask This bit is not applicable in Scatter/Gather DMA mode.
5	RW	0x0	AckMsk ACK Response Received/Transmitted Interrupt Mask This bit is not applicable in Scatter/Gather DMA mode.
4	RW	0x0	NakMsk NAK Response Received Interrupt Mask This bit is not applicable in Scatter/Gather DMA mode.
3	RW	0x0	StallMsk STALL Response Received Interrupt Mask This bit is not applicable in Scatter/Gather DMA mode.
2	RW	0x0	AHBErrMsk AHB Error Mask Note: This bit is only accessible when OTG_ARCHITECTURE = 2
1	RW	0x0	ChHltedMsk Channel Halted Mask
0	RW	0x0	XferComplMsk Transfer Completed Mask This bit is valid only when Scatter/Gather DMA mode is enabled. In non Scatter/Gather DMA mode, this bit is reserved.

USBOTG_HCTSIZn

Address: Operational Base + offset (0x0510 + 0x20 * n) 0≤n≤15

Host Channel-n Transfer Size Register(In Scatter/Gather DMA mode)

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>DoPng Do Ping</p> <p>This bit is used only for OUT transfers. Setting this field to 1 directs the host to do PING protocol.</p> <p>Note: Do not set this bit for IN transfers. If this bit is set for IN transfers it disables the channel.</p>
30:29	RW	0x0	<p>Pid PID</p> <p>The application programs this field with the type of PID to use for the initial transaction.</p> <p>The host maintains this field for the rest of the transfer.</p> <p>2'b00: DATA0 2'b01: DATA2 2'b10: DATA1 2'b11: MDATA (non-control)/SETUP (control)</p>
28:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:8	RW	0x000	<p>NTD Number of Transfer Descriptors (Non Isochronous) This value is in terms of number of descriptors. Maximum number of descriptor that can be present in the list is 64. The values can be from 0 to 63.</p> <ul style="list-style-type: none"> • 0 – 1 descriptor. • 63 – 64 descriptors <p>This field indicates the total number of descriptors present in that list. The core will wrap around after servicing NTD number of descriptors for that list.</p> <p>(Isochronous) This field indicates the number of descriptors present in that list.µframe. The possible values for FS are</p> <ul style="list-style-type: none"> • 1 – 2 descriptors • 3 – 4 descriptors • 7 – 8 descriptors • 15 – 16 descriptors • 31 – 32 descriptors • 63 – 64 descriptors <p>The possible values for HS are</p> <ul style="list-style-type: none"> • 7 – 8 descriptors • 15 – 16 descriptors • 31 – 32 descriptors • 63 – 64 descriptors • 127 – 128 descriptors • 255 – 256 descriptors

Bit	Attr	Reset Value	Description
18:0	RW	0x00000	<p>SCED_INFO Schedule information Every bit in this 8 bit register indicates scheduling for that microframe. Bit 0 indicates scheduling for 1st microframe and bit 7 indicates scheduling for 8th microframe in that frame. A value of 8'b11111111 indicates that the corresponding interrupt channel is scheduled to issue a token every microframe in that frame. A value of 8'b10101010 indicates that the corresponding interrupt channel is scheduled to issue a token every alternate microframe starting with second microframe.</p> <p>Note that this field is applicable only for periodic (Isochronous and Interrupt) channels.</p>

Host Channel-n Transfer Size Register (In Non Scatter/Gather DMA mode)

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>DoPng Do Ping This bit is used only for OUT transfers. Setting this field to 1 directs the host to do PING protocol. Note: Do not set this bit for IN transfers. If this bit is set for IN transfers it disables the channel.</p>
30:29	RW	0x0	<p>Pid PID The application programs this field with the type of PID to use for the initial transaction. The host maintains this field for the rest of the transfer.</p> <p>2'b00: DATA0 2'b01: DATA2 2'b10: DATA1 2'b11: MDATA (non-control)/SETUP (control)</p>

Bit	Attr	Reset Value	Description
28:19	RW	0x000	PktCnt Packet Count This field is programmed by the application with the expected number of packets to be transmitted (OUT) or received (IN). The host decrements this count on every successful transmission or reception of an OUT/IN packet. Once this count reaches zero, the application is interrupted to indicate normal completion. The width of this counter is specified as Width of Packet Counters (parameter OTG_PACKET_COUNT_WIDTH).
18:0	RW	0x00000	XferSize Transfer Size For an OUT, this field is the number of data bytes the host sends during the transfer. For an IN, this field is the buffer size that the application has Reserved for the transfer. The application is expected to program this field as an integer multiple of the maximum packet size for IN transactions (periodic and non-periodic). The width of this counter is specified as Width of Transfer Size Counters (parameter OTG_TRANS_COUNT_WIDTH).

USBOTG_HCDMAN

Address: Operational Base + offset (0x0514 + 0x20 * n) 0≤n≤15

Host Channel-n DMA Address Register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	DMAAddr DMA Address This field holds the start address in the external memory from which the data for the endpoint must be fetched or to which it must be stored. This register is incremented on every AHB transaction.

USBOTG_HCDMABn

Address: Operational Base + offset (0x051c + 0x20 * n) 0≤n≤15

Host Channel-n DMA Buffer Address Register

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	HCDMABn Holds the current buffer address This register is updated as and when the data transfer for the corresponding end point is in progress. This register is present only in Scatter/Gather DMA mode. Otherwise this field is reserved.

Host Channel-n DMA Descriptor Address Register

Bit	Attr	Reset Value	Description
31:N (Isoc) 31:9 (Non Isoc)	RW	0x00000000	(DMAAddr) DMA Address Non-Isochronous: This field holds the start address of the 512 bytes page. The first descriptor in the list should be located in this address. The first descriptor may be or may not be ready. The core starts processing the list from the CTD value. Isochronous: This field holds the address of the $2*(nTD+1)$ bytes of locations in which the isochronous descriptors are present where N is based on nTD as per Table below

31:N	N-1:3	2:0
Base Address	Offset	000

HS ISOC	
nTD	N
7	6
15	7
31	8
63	9
127	10
255	11

FS ISOC	
nTD	N
1	4
3	5
7	6
15	7
31	8
63	9

Bit	Attr	Reset Value	Description
N-1:3 (Isoc) 8:3 (Non Isoc)	RW	0x00000000	<p>CTD Current Transfer Desc Non Isochronous: This value is in terms of number of descriptors. The values can be from 0 to 63. 0 – 1 descriptor. 63- 64 descriptors.</p> <p>This field indicates the current descriptor processed in the list. This field is updated both by application and the core. For example, if the application enables the channel after programming CTD=5, then the core will start processing the 6th descriptor. The address is obtained by adding a value of (8bytes*5=) 40(decimal) to DMAAddr.</p> <p>Isochronous: CTD for isochronous is based on the current frame/μframe value. Need to be set to zero by application.</p>
2:0	RO	0x0	reserved

USBOTG_DCFG

Address: Operational Base + offset (0x0800)

Device Configuration Register

Bit	Attr	Reset Value	Description
31:26	RW	0x02	<p>ResValid Resume Validation Period</p> <p>This field controls the period when the core resumes from a suspend. When this bit is set, the core counts for the ResValid number of clock cycles to detect a valid resume. This field is effective only when DCFG.Ena32KHzSusp is set.</p>

Bit	Attr	Reset Value	Description
25:24	RW	0x0	<p>PerSchIntvl Periodic Scheduling Interval PerSchIntvl must be programmed only for Scatter/Gather DMA mode. Description: This field specifies the amount of time the Internal DMA engine must allocate for fetching periodic IN endpoint data. Based on the number of periodic endpoints, this value must be specified as 25,50 or 75% of (micro)frame. When any periodic endpoints are active, the internal DMA engine allocates the specified amount of time in fetching periodic IN endpoint data. When no periodic endpoints are active, then the internal DMA engine services nonperiodic endpoints, ignoring this field. After the specified time within a (micro)frame, the DMA switches to fetching for nonperiodic endpoints.</p> <p>2'b00: 25% of (micro)frame. 2'b01: 50% of (micro)frame. 2'b10: 75% of (micro)frame. 2'b11: Reserved.</p>
23	RW	0x0	<p>DescDMA Enable Scatter/Gather DMA in Device mode When the Scatter/Gather DMA option selected during configuration of the RTL, the application can set this bit during initialization to enable the Scatter/Gather DMA operation. NOTE: This bit must be modified only once after a reset. The following combinations are available for programming:</p> <p>GAHBCFG.DMAEn=0, DCFG.DescDMA=0 => Slave mode GAHBCFG.DMAEn=0, DCFG.DescDMA=1 => Invalid GAHBCFG.DMAEn=1, DCFG.DescDMA=0 => Buffered DMA mode GAHBCFG.DMAEn=1, DCFG.DescDMA=1 => Scatter/Gather DMA mode</p>

Bit	Attr	Reset Value	Description
22:18	RW	0x08	EPMisCnt IN Endpoint Mismatch Count This field is valid only in shared FIFO operation. The application programs this field with a count that determines when the core generates an Endpoint Mismatch interrupt (GINTSTS.EPMis). The core loads this value into an internal counter and decrements it. The counter is reloaded whenever there is a match or when the counter expires. The width of this counter depends on the depth of the Token Queue.
17:13	RO	0x0	reserved
12:11	RW	0x0	PerFrInt Periodic Frame Interval Indicates the time within a (micro)frame at which the application must be notified using the End Of Periodic Frame Interrupt. This can be used to determine if all the isochronous traffic for that (micro)frame is complete. 2'b00: 80% of the (micro)frame interval 2'b01: 85% 2'b10: 90% 2'b11: 95%
10:4	RW	0x00	DevAddr Device Address The application must program this field after every SetAddress control command.
3	RW	0x0	Ena32KHzS Enable 32-KHz Suspend Mode When the USB 1.1 Full-Speed Serial Transceiver Interface is chosen and this bit is set, the core expects the 48-MHz PHY clock to be switched to 32 KHz during a suspend. This bit can only be set if USB 1.1 Full-Speed Serial Transceiver Interface has been selected. If USB 1.1 Full-Speed Serial Transceiver Interface has not been selected, this bit must be zero.

Bit	Attr	Reset Value	Description
2	RW	0x0	<p>NZStsOUTHShk Non-Zero-Length Status OUT Handshake The application can use this field to select the handshake the core sends on receiving a nonzero-length data packet during the OUT transaction of a control transfer's Status stage.</p> <p>1'b1: Send a STALL handshake on a nonzero-length status OUT transaction and do not send the received OUT packet to the application.</p> <p>1'b0: Send the received OUT packet to the application (zero-length or nonzerolength) and send a handshake based on the NAK and STALL bits for the endpoint in the Device Endpoint Control register.</p>
1:0	RW	0x0	<p>DevSpd Device Speed Indicates the speed at which the application requires the core to enumerate, or the maximum speed the application can support. However, the actual bus speed is determined only after the chirp sequence is completed, and is based on the speed of the USB host to which the core is connected.</p> <p>2'b00: High speed (USB 2.0 PHY clock is 30 MHz or 60 MHz)</p> <p>2'b01: Full speed (USB 2.0 PHY clock is 30 MHz or 60 MHz)</p> <p>2'b10: Reserved</p> <p>2'b11: Full speed (USB 1.1 transceiver clock is 48 MHz)</p>

USBOTG_DCTL

Address: Operational Base + offset (0x0804)

Device Control Register

Bit	Attr	Reset Value	Description
31:17	RO	0x0	reserved
16	RW	0x0	<p>NakOnBble Set NAK automatically on babble The core sets NAK automatically for the endpoint on which babble is received.</p>

Bit	Attr	Reset Value	Description
15	RW	0x0	<p>IgnrFrmNum Ignore frame number for isochronous endpoints in case of Scatter</p> <p>Do NOT program IgnrFrmNum bit to 1'b1 when the core is operating in Threshold mode. Note: When Scatter/Gather DMA mode is enabled this feature is not applicable to highspeed, high-bandwidth transfers. When this bit is enabled, there must be only one packet per descriptor.</p> <p>0: The core transmits the packets only in the frame number in which they are intended to be transmitted.</p> <p>1: The core ignores the frame number, sending packets immediately as the packets are ready.</p> <p>Scatter/Gather: In Scatter/Gather DMA mode, when this bit is enabled, the packets are not flushed when an ISOC IN token is received for an elapsed frame. When Scatter/Gather DMA mode is disabled, this field is used by the application to enable periodic transfer interrupt. The application can program periodic endpoint transfers for multiple (micro)frames.</p> <p>0: Periodic transfer interrupt feature is disabled; the application must program transfers for periodic endpoints every (micro)frame</p> <p>1: Periodic transfer interrupt feature is enabled; the application can program transfers for multiple (micro)frames for periodic endpoints.</p> <p>In non-Scatter/Gather DMA mode, the application receives transfer complete interrupt after transfers for multiple (micro)frames are completed.</p>

Bit	Attr	Reset Value	Description
14:13	RW	0x1	<p>GMC Global Multi Count GMC must be programmed only once after initialization. Applicable only for Scatter/Gather DMA mode. This indicates the number of packets to be serviced for that end point before moving to the next end point. It is only for nonperiodic end points.</p> <p>2'b00: Invalid. 2'b01: 1 packet. 2'b10: 2 packets. 2'b11: 3 packets.</p> <p>When Scatter/Gather DMA mode is disabled, this field is reserved. and reads 2'b00.</p>
12	RO	0x0	reserved
11	RW	0x0	<p>PWROnPrgDone Power-On Programming Done The application uses this bit to indicate that register programming is completed after a wake-up from Power Down mode.</p>
10	WO	0x0	<p>CGOUTNak Clear Global OUT NAK A write to this field clears the Global OUT NAK.</p>
9	WO	0x0	<p>SGOUTNak Set Global OUT NAK A write to this field sets the Global OUT NAK. The application uses this bit to send a NAK handshake on all OUT endpoints. The application must set the this bit only after making sure that the Global OUT NAK Effective bit in the Core Interrupt Register (GINTSTS.GOUTNakEff) is cleared.</p>
8	WO	0x0	<p>CGNPInNak Clear Global Non-periodic IN NAK A write to this field clears the Global Non-periodic IN NAK.</p>

Bit	Attr	Reset Value	Description
7	WO	0x0	<p>SGNPIInNak Set Global Non-periodic IN NAK A write to this field sets the Global Non-periodic IN NAK. The application uses this bit to send a NAK handshake on all non-periodic IN endpoints. The core can also set this bit when a timeout condition is detected on a non-periodic endpoint in shared FIFO operation. The application must set this bit only after making sure that the Global IN NAK Effective bit in the Core Interrupt Register (GINTSTS.GINNakEff) is cleared.</p>
6:4	RW	0x0	<p>TstCtl Test Control 3'b000: Test mode disabled 3'b001: Test_J mode 3'b010: Test_K mode 3'b011: Test_SE0_NAK mode 3'b100: Test_Packet mode 3'b101: Test_Force_Enable Others: Reserved</p>
3	RO	0x0	<p>GOUTNakSts Global OUT NAK Status 1'b0: A handshake is sent based on the FIFO Status and the NAK and STALL bit settings. 1'b1: No data is written to the RxFIFO, irrespective of space availability. Sends a NAK handshake on all packets, except on SETUP transactions. All isochronous OUT packets are dropped</p>
2	RO	0x0	<p>GNPINNakSts Global Non-periodic IN NAK Status 1'b0: A handshake is sent out based on the data availability in the transmit FIFO. 1'b1: A NAK handshake is sent out on all non-periodic IN endpoints, irrespective of the data availability in the transmit FIFO.</p>

Bit	Attr	Reset Value	Description
1	RW	0x0	<p>SftDiscon Soft Disconnect</p> <p>The application uses this bit to signal the OTG core to do a soft disconnect. As long as this bit is set, the host does not see that the device is connected, and the device does not receive signals on the USB. The core stays in the disconnected state until the application clears this bit.</p> <p>1'b0: Normal operation. When this bit is cleared after a soft disconnect, the core drives the phy_opmode_o signal on the UTMI+ to 2'b00, which generates a device connect event to the USB host. When the device is reconnected, the USB host restarts device enumeration.</p> <p>1'b1: The core drives the phy_opmode_o signal on the UTMI+ to 2'b01, which generates a device disconnect event to the USB host.</p>
0	RW	0x0	<p>RmtWkUpSig Remote Wakeup Signaling</p> <p>When the application sets this bit, the core initiates remote signaling to wake the USB host. The application must set this bit to instruct the core to exit the Suspend state. As specified in the USB 2.0 specification, the application must clear this bit 1ms after setting it. If LPM is enabled and the core is in the L1 (Sleep) state, when the application sets this bit, the core initiates L1 remote signaling to wake up the USB host. The application must set this bit to instruct the core to exit the Sleep state. As specified in the LPM specification, the hardware automatically clears this bit 50 us (TL1DevDrvResume) after being set by the application. The application must not set this bit when GLPMCFG bRemoteWake from the previous LPM transaction is zero.</p>

USBOTG_DSTS

Address: Operational Base + offset (0x0808)

Device Status Register

Bit	Attr	Reset Value	Description
31:22	RO	0x0	reserved
21:8	RW	0x0000	<p>SOFFN Frame or Microframe Number of the Received SOF</p> <p>When the core is operating at high speed, this field contains a microframe number. When the core is operating at full or low speed, this field contains a frame number.</p>
7:4	RO	0x0	reserved
3	RW	0x0	<p>ErrticErr Erratic Error</p> <p>The core sets this bit to report any erratic errors (phy_rxvalid_i/phy_rxvldh_i or phy_rxactive_i is asserted for at least 2 ms, due to PHY error) seen on the UTMI+. Due to erratic errors, the OTG core goes into Suspended state and an interrupt is generated to the application with Early Suspend bit of the Core Interrupt register (GINTSTS.ErlySusp). If the early suspend is asserted due to an erratic error, the application can only perform a soft disconnect recover.</p>
2:1	RW	0x0	<p>EnumSpd Enumerated Speed</p> <p>Indicates the speed at which the OTG core has come up after speed detection through a chirp sequence.</p> <p>2'b00: High speed (PHY clock is running at 30 or 60 MHz)</p> <p>2'b01: Full speed (PHY clock is running at 30 or 60 MHz)</p> <p>2'b10: Low speed (PHY clock is running at 48 MHz, internal phy_clk at 6 MHz)</p> <p>2'b11: Full speed (PHY clock is running at 48 MHz)</p> <p>Low speed is not supported for devices using a UTMI+ PHY.</p>

Bit	Attr	Reset Value	Description
0	RW	0x0	SuspSts Suspend Status In Device mode, this bit is set as long as a Suspend condition is detected on the USB. The core enters the Suspended state when there is no activity on the utmi_linestate signal for an extended period of time. The core comes out of the suspend: When there is any activity on the utmi_linestate signal, When the application writes to the Remote Wakeup Signaling bit in the Device Control register (DCTL.RmtWkUpSig).

USBOTG_DIEPMSK

Address: Operational Base + offset (0x0810)

Device IN Endpoint common interrupt mask register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RW	0x0	NAKMsk NAK interrupt Mask
12:10	RO	0x0	reserved
9	RW	0x0	BNAInIntrMsk BNA Interrupt Mask
8	RW	0x0	TxfifoUndrnMsk Fifo Underrun Mask
7	RO	0x0	reserved
6	RW	0x0	INEPNakEffMsk IN Endpoint NAK Effective Mask
5	RW	0x0	INTknEPMisMsk IN Token received with EP Mismatch Mask
4	RW	0x0	INTknTxFTEmpMsk IN Token Received When Tx FIFO Empty Mask
3	RW	0x0	TimeOUTMsk Timeout Condition Mask
2	RW	0x0	AHBErrMsk AHB Error Mask
1	RW	0x0	EPDisbldMsk Endpoint Disabled Interrupt Mask
0	RW	0x0	XferComplMsk Transfer Completed Interrupt Mask

USBOTG_DOEPMSK

Address: Operational Base + offset (0x0814)

Device OUT Endpoint common interrupt mask register

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14	RW	0x0	NYETMsk NYET Interrupt Mask
13	RW	0x0	NAKMsk NAK Interrupt Mask
12	RW	0x0	BbleErrMsk Babble Interrupt Mask
11:10	RO	0x0	reserved
9	RW	0x0	BnaOutIntrMsk BNA interrupt Mask
8	RW	0x0	OutPktErrMsk OUT Packet Error Mask
7	RO	0x0	reserved
6	RW	0x0	Back2BackSETup Back-to-Back SETUP Packets Received Mask Applies to control OUT endpoints only.
5	RO	0x0	reserved
4	RW	0x0	OUTTknEPdisMsk OUT Token Received when Endpoint Disabled Mask Applies to control OUT endpoints only.
3	RW	0x0	SetUPMsk SETUP Phase Done Mask Applies to control endpoints only.
2	RW	0x0	AHBErrMsk AHB Error
1	RW	0x0	EPDisbldMsk Endpoint Disabled Interrupt Mask
0	RW	0x0	XferComplMsk Transfer Completed Interrupt Mask

USBOTG_DAIN

Address: Operational Base + offset (0x0818)

Device All Endpoints interrupt register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	OutEPInt OUT Endpoint Interrupt Bits One bit per OUT endpoint: Bit 16 for OUT endpoint 0, bit 31 for OUT endpoint 15

Bit	Attr	Reset Value	Description
15:0	RO	0x0000	InEpInt IN Endpoint Interrupt Bits One bit per IN Endpoint: Bit 0 for IN endpoint 0, bit 15 for endpoint 15

USBOTG_DAINTMSK

Address: Operational Base + offset (0x081c)

Device All Endpoint interrupt mask register

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	OutEpMsk OUT EP Interrupt Mask Bits One per OUT Endpoint: Bit 16 for OUT EP 0, bit 31 for OUT EP 15
15:0	RW	0x0000	InEpMsk IN EP Interrupt Mask Bits One bit per IN Endpoint: Bit 0 for IN EP 0, bit 15 for IN EP 15

USBOTG_DTKNQR1

Address: Operational Base + offset (0x0820)

Device IN token sequence learning queue read register1

Bit	Attr	Reset Value	Description
31:8	RO	0x0000000	EPTkn Endpoint Token Four bits per token represent the endpoint number of the token: Bits [31:28]: Endpoint number of Token 5 Bits [27:24]: Endpoint number of Token 4 Bits [15:12]: Endpoint number of Token 1 Bits [11:8]: Endpoint number of Token 0
7	RO	0x0	WrapBit Wrap Bit This bit is set when the write pointer wraps. It is cleared when the learning queue is cleared.
6:5	RO	0x0	reserved
4:0	RO	0x00	INTknWPtr IN Token Queue Write Pointer

USBOTG_DTKNQR2

Address: Operational Base + offset (0x0824)

Device IN token sequence learning queue read register2

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPTkn Endpoint Token Four bits per token represent the endpoint number of the token: Bits [31:28]: Endpoint number of Token 13 Bits [27:24]: Endpoint number of Token 12 Bits [7:4]: Endpoint number of Token 7 Bits [3:0]: Endpoint number of Token 6

USBOTG_DVBUSDIS

Address: Operational Base + offset (0x0828)

Device VBUS discharge time register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0b8f	DVBUSDis Device VBUS Discharge Time Specifies the VBUS discharge time after VBUS pulsing during SRP. This value equals: VBUS discharge time in PHY clocks / 1,024. The value you use depends whether the PHY is operating at 30 MHz (16-bit data width) or 60 MHz (8-bit data width). Depending on your VBUS load, this value can need adjustment.

USBOTG_DVBUSPULSE

Address: Operational Base + offset (0x082c)

Device VBUS Pulsing Timer Register

Bit	Attr	Reset Value	Description
31:12	RO	0x0	reserved
11:0	RW	0x000	DVBUSPulse Device VBUS Pulsing Time Specifies the VBUS pulsing time during SRP. This value equals: VBUS pulsing time in PHY clocks / 1,024. The value you use depends whether the PHY is operating at 30 MHz (16-bit data width) or 60 MHz (8-bit data width).

USBOTG_DTHRCTL

Address: Operational Base + offset (0x0830)

Device Threshold Control Register

Bit	Attr	Reset Value	Description
31:28	RO	0x0	reserved
27	RW	0x1	ArbPrkEn Arbiter Parking Enable This bit controls internal DMA arbiter parking for IN endpoints. When thresholding is enabled and this bit is set to one, then the arbiter parks on the IN endpoint for which there is a token received on the USB. This is done to avoid getting into underrun conditions. By default the parking is enabled.
26	RO	0x0	reserved
25:17	RW	0x008	RxThrLen Receive Threshold Length This field specifies Receive thresholding size in DWORDS. This field also specifies the amount of data received on the USB before the core can start transmitting on the AHB. The threshold length has to be at least eight DWORDS. The recommended value for ThrLen is to be the same as the programmed AHB Burst Length (GAHBCFG.HBstLen).
16	RW	0x0	RxThrEn Receive Threshold Enable When this bit is set, the core enables thresholding in the receive direction.
15:13	RO	0x0	reserved

Bit	Attr	Reset Value	Description
12:11	RW	0x0	<p>AHBThrRatio AHB Threshold Ratio These bits define the ratio between the AHB threshold and the MAC threshold for the transmit path only. The AHB threshold always remains less than or equal to the USB threshold, because this does not increase overhead. Both the AHB and the MAC threshold must be DWORD-aligned. The application needs to program TxThrLen and the AHBThrRatio to make the AHB Threshold value DWORD aligned. If the AHB threshold value is not DWORD aligned, the core might not behave correctly. When programming the TxThrLen and AHBThrRatio, the application must ensure that the minimum AHB threshold value does not go below 8 DWORDS to meet the USB turnaround time requirements.</p> <p>2'b00: AHB threshold = MAC threshold 2'b01: AHB threshold = MAC threshold / 2 2'b10: AHB threshold = MAC threshold / 4 2'b11: AHB threshold = MAC threshold / 8</p>
10:2	RW	0x008	<p>TxThrLen Transmit Threshold Length This field specifies Transmit thresholding size in DWORDS. This field also forms the MAC threshold and specifies the amount of data, in bytes, to be in the corresponding endpoint transmit FIFO before the core can start a transmit on the USB. When the value of AHBThrRatio is 2'h00, the threshold length must be at least 8 DWORDS. If the AHBThrRatio is nonzero, the application must ensure that the AHB threshold value does not go below the recommended 8 DWORDS. This field controls both isochronous and non-isochronous IN endpoint thresholds. The recommended value for ThrLen is to be the same as the programmed AHB Burst Length (GAHBCFG.HBstLen).</p>

Bit	Attr	Reset Value	Description
1	RW	0x0	ISOThrEn ISO IN Endpoints Threshold Enable When this bit is set, the core enables thresholding for isochronous IN endpoints.
0	RW	0x0	NonISOThrEn Non-ISO IN Endpoints Threshold Enable When this bit is set, the core enables thresholding for Non Isochronous IN endpoints.

USBOTG_DIEPEMPMSK

Address: Operational Base + offset (0x0834)

Device IN endpoint FIFO empty interrupt mask register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	InEpTxfEmpMsk IN EP Tx FIFO Empty Interrupt Mask Bits These bits acts as mask bits for DIEPINTn. TxFEmp interrupt One bit per IN Endpoint: Bit 0 for IN endpoint 0 ... Bit 15 for endpoint 15

USBOTG_DEACHINT

Address: Operational Base + offset (0x0838)

Device each endpoint interrupt register

Bit	Attr	Reset Value	Description
31:16	RO	0x0000	EchOutEPInt OUT Endpoint Interrupt Bits One bit per OUT endpoint: Bit 16 for OUT endpoint 0 ... Bit 31 for OUT endpoint 15
15:0	RO	0x0000	EchInEpInt IN Endpoint Interrupt Bits One bit per IN Endpoint: Bit 0 for IN endpoint 0 ... Bit 15 for endpoint 15

USBOTG_DEACHINTMSK

Address: Operational Base + offset (0x083c)

Device each endpoint interrupt register mask

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	EchOutEpMsk OUT EP Interrupt Mask Bits One per OUT Endpoint: Bit 16 for IN endpoint 0 ... Bit 31 for endpoint 15
15:0	RW	0x0000	EchInEpMsk IN EP Interrupt Mask Bits One bit per IN Endpoint: Bit 0 for IN endpoint 0 ... Bit 15 for endpoint 15

USBOTG_DIEPEACHMSKn

Address: Operational Base + offset (0x0840 + 0x4 * n) 0≤n≤15

Device each IN endpoint -n interrupt Register

Bit	Attr	Reset Value	Description
31:14	RO	0x0	reserved
13	RW	0x0	NAKMsk NAK interrupt Mask
12:10	RO	0x0	reserved
9	RW	0x0	BNAInIntrMsk BNA interrupt Mask
8	RW	0x0	TxfifoUndrnMsk Fifo Under run Mask
7	RO	0x0	reserved
6	RW	0x0	INEPNakEffMsk IN Endpoint NAK Effective Mask
5	RW	0x0	INTknEPMisMsk IN Token received with EP Mismatch Mask
4	RW	0x0	INTknTXFEmpMsk IN Token Received When TxFIFO Empty Mask
3	RW	0x0	TimeOUTMsk Timeout Condition Mask(Non-isochronous endpoints)
2	RW	0x0	AHBErrMsk AHB Error Mask
1	RW	0x0	EPDisbldMsk Endpoint Disabled Interrupt Mask
0	RW	0x0	XferComplMsk Transfer Completed Interrupt Mask

USBOTG_DOEPEACHMSKn

Address: Operational Base + offset (0x0880 + 0x4 * n) 0≤n≤15
Device each out endpoint-n interrupt register

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14	RW	0x0	NYETMsk NYET interrupt Mask
13	RW	0x0	NAKMsk NAK interrupt Mask
12	RW	0x0	BbleErrMsk Babble interrupt Mask
11:10	RO	0x0	reserved
9	RW	0x0	BnaOutIntrMsk BNA interrupt Mask
8	RW	0x0	OutPktErrMsk OUT Packet Error Mask
7	RO	0x0	reserved
6	RW	0x0	Back2BackSETup Back-to-Back SETUP Packets Received Mask Applies to control OUT endpoints only.
5	RO	0x0	reserved
4	RW	0x0	OUTTknEPdisMsk OUT Token Received when Endpoint Disabled Mask Applies to control OUT endpoints only.
3	RW	0x0	SetUPMsk SETUP Phase Done Mask Applies to control endpoints only.
2	RW	0x0	AHBErrMsk AHB Error
1	RW	0x0	EPDisbldMsk Endpoint Disabled Interrupt Mask
0	RW	0x0	XferComplMsk Transfer Completed Interrupt Mask

USBOTG_DIEPCTL0

Address: Operational Base + offset (0x0900)
Device control IN endpoint 0 control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31	RWSC	0x0	<p>EPEna Endpoint Enable When Scatter/Gather DMA mode is enabled, for IN endpoints this bit indicates that the descriptor structure and data buffer with data ready to transmit is setup. When Scatter/Gather DMA mode is disabled-such as in buffer-pointer based DMA mode-this bit indicates that data is ready to be transmitted on the endpoint. The core clears this bit before setting the following interrupts on this endpoint: Endpoint Disabled; Transfer Completed.</p>
30	RWSC	0x0	<p>EPDis Endpoint Disable The application sets this bit to stop transmitting data on an endpoint, even before the transfer for that endpoint is complete. The application must wait for the Endpoint Disabled interrupt before treating the endpoint as disabled. The core clears this bit before setting the Endpoint Disabled Interrupt. The application must set this bit only if Endpoint Enable is already set for this endpoint.</p>
29:28	RO	0x0	reserved
27	WO	0x0	<p>SNAK Set NAK A write to this bit sets the NAK bit for the endpoint. Using this bit, the application can control the transmission of NAK handshakes on an endpoint. The core can also set this bit for an endpoint after a SETUP packet is received on that endpoint.</p>
26	WO	0x0	<p>CNAK Clear NAK A write to this bit clears the NAK bit for the endpoint.</p>
25:23	RO	0x0	reserved

Bit	Attr	Reset Value	Description
22	RW	0x0	TxFNum TxFIFO Number For Shared FIFO operation, this value is always set to 0, indicating that control IN endpoint 0 data is always written in the Non-Periodic Transmit FIFO. For Dedicated FIFO operation, this value is set to the FIFO number that is assigned to IN Endpoint 0.
21	RWSC	0x0	Stall STALL Handshake The application can only set this bit, and the core clears it, when a SETUP token is received for this endpoint. If a NAK bit, Global Non-periodic IN NAK, or Global OUT NAK is set along with this bit, the STALL bit takes priority.
20	RO	0x0	reserved
19:18	RO	0x0	EPType Endpoint Type Hardcoded to 00 for control
17	RO	0x0	NAKsts NAK Status Indicates the following: 1'b0: The core is transmitting non-NAK handshakes based on the FIFO status 1'b1: The core is transmitting NAK handshakes on this endpoint. When this bit is set, either by the application or core, the core stops transmitting data, even if there is data available in the TxFIFO. Irrespective of this bit's setting, the core always responds to SETUP data packets with an ACK handshake.
16	RO	0x0	reserved
15	RO	0x1	USBActEP USB Active Endpoint This bit is always set to 1, indicating that control endpoint 0 is always active in all configurations and interfaces.

Bit	Attr	Reset Value	Description
14:11	RW	0x0	NextEp Next Endpoint Applies to non-periodic IN endpoints only. Indicates the endpoint number to be fetched after the data for the current endpoint is fetched. The core can access this field, even when the Endpoint Enable (EPEna) bit is not set. This field is not valid in Slave mode. Note: This field is valid only for Shared FIFO operations.
10:2	RO	0x0	reserved
1:0	RW	0x0	MPS Maximum Packet Size Applies to IN and OUT endpoints. The application must program this field with the maximum packet size for the current logical endpoint. 2'b00: 64 bytes 2'b01: 32 bytes 2'b10: 16 bytes 2'b11: 8 bytes

USBOTG_DIEPINTn

Address: Operational Base + offset (0x0908 + 0x20 * n) 0≤n≤15

Device Endpoint-n Interrupt Register

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14	W1C	0x0	NYETIntrpt NYET interrupt The core generates this interrupt when a NYET response is transmitted for a non isochronous OUT endpoint.
13	W1C	0x0	NAKIntrpt NAK interrupt The core generates this interrupt when a NAK is transmitted or received by the device. In case of isochronous IN endpoints the interrupt gets generated when a zero length packet is transmitted due to un-availability of data in the TXFifo.

Bit	Attr	Reset Value	Description
12	W1C	0x0	BbleErrIntrpt BbleErr (Babble Error) interrupt The core generates this interrupt when babble is received for the endpoint.
11	W1C	0x0	PktDrpSts Packet Dropped Status This bit indicates to the application that an ISOC OUT packet has been dropped. This bit does not have an associated mask bit and does not generate an interrupt. Dependency: This bit is valid in non Scatter/Gather DMA mode when periodic transfer interrupt feature is selected.
10	RO	0x0	reserved
9	W1C	0x0	BNAIntr BNA (Buffer Not Available) Interrupt The core generates this interrupt when the descriptor accessed is not ready for the Core to process, such as Host busy or DMA done Dependency: This bit is valid only when Scatter/Gather DMA mode is enabled.
8	W1C	0x0	TxfifoUndrn FIFO Underrun Applies to IN endpoints only. The core generates this interrupt when it detects a transmit FIFO underrun condition for this endpoint. Dependency: This interrupt is valid only when both of the following conditions are true: Parameter OTG_ENDED_TX_FIFO==1; Thresholding is enabled; OUT Packet Error(OutPktErr). Applies to OUT endpoints only. This interrupt is asserted when the core detects an overflow or a CRC error for an OUT packet. Dependency: This interrupt is valid only when both of the following conditions are true: Parameter OTG_ENDED_TX_FIFO==1; Thresholding is enabled.

Bit	Attr	Reset Value	Description
7	W1C	0x0	<p>TxFEmp Transmit FIFO Empty This bit is valid only for IN Endpoints. This interrupt is asserted when the Tx FIFO for this endpoint is either half or completely empty. The half or completely empty status is determined by the Tx FIFO Empty Level bit in the Core AHB Configuration register (GAHBCFG.NPTxFEmpLvl)).</p>
6	W1C	0x0	<p>INEPNakEff IN Endpoint NAK Effective Applies to periodic IN endpoints only. This bit can be cleared when the application clears the IN endpoint NAK by writing to DIEPCTLn.CNAK. This interrupt indicates that the core has sampled the NAK bit set (either by the application or by the core). The interrupt indicates that the IN endpoint NAK bit set by the application has taken effect in the core. This interrupt does not guarantee that a NAK handshake is sent on the USB. A STALL bit takes priority over a NAK bit. This bit is applicable only when the endpoint is enabled. Back-to-Back SETUP Packets Received (Back2BackSETup) Applies to Control OUT endpoints only. This bit indicates that the core has received more than three back-to-back SETUP packets for this particular endpoint.</p>

Bit	Attr	Reset Value	Description
5	W1C	0x0	<p>INTknEPMis IN Token Received with EP Mismatch Applies to non-periodic IN endpoints only. Indicates that the data in the top of the non-periodic TxFIFO belongs to an endpoint other than the one for which the IN token was received. This interrupt is asserted on the endpoint for which the IN token was received.</p> <p>Status Phase Received For Control Write (StsPhseRcvd) This interrupt is valid only for Control OUT endpoints and only in Scatter Gather DMA mode. This interrupt is generated only after the core has transferred all the data that the host has sent during the data phase of a control write transfer, to the system memory buffer. The interrupt indicates to the application that the host has switched from data phase to the status phase of a Control Write transfer. The application can use this interrupt to ACK or STALL the Status phase, after it has decoded the data phase. This is applicable only in case of Scatter Gather DMA mode.</p>
4	W1C	0x0	<p>INTknTxFEmp IN Token Received When TxFIFO is Empty Indicates that an IN token was received when the associated TxFIFO periodic/nonperiodic) was empty. This interrupt is asserted on the endpoint for which the IN token was received.</p> <p>OUT Token Received When Endpoint Disabled (OUTTknEPdis) Indicates that an OUT token was received when the endpoint was not yet enabled. This interrupt is asserted on the endpoint for which the OUT token was received.</p>

Bit	Attr	Reset Value	Description
3	W1C	0x0	TimeOUT Timeout Condition In shared TX FIFO mode, applies to non-isochronous IN endpoints only. In dedicated FIFO mode, applies only to Control IN endpoints. In Scatter/Gather DMA mode, the TimeOUT interrupt is not asserted. Indicates that the core has detected a timeout condition on the USB for the last IN token on this endpoint. SETUP Phase Done (SetUp) Applies to control OUT endpoints only. Indicates that the SETUP phase for the control endpoint is complete and no more back-to-back SETUP packets were received for the current control transfer. On this interrupt, the application can decode the received SETUP data packet.
2	W1C	0x0	AHBErr AHB Error Applies to IN and OUT endpoints. This is generated only in Internal DMA mode when there is an AHB error during an AHB read/write. The application can read the corresponding endpoint DMA address register to get the error address.
1	W1C	0x0	EPDisbld Endpoint Disabled Interrupt Applies to IN and OUT endpoints. This bit indicates that the endpoint is disabled per the application's request.

Bit	Attr	Reset Value	Description
0	W1C	0x0	XferCompl Transfer Completed Interrupt Applies to IN and OUT endpoints. When Scatter/Gather DMA mode is enabled: For IN endpoint this field indicates that the requested data from the descriptor is moved from external system memory to internal FIFO. For OUT endpoint this field indicates that the requested data from the internal FIFO is moved to external system memory. This interrupt is generated only when the corresponding endpoint descriptor is closed, and the IOC bit for the corresponding descriptor is set. When Scatter/Gather DMA mode is disabled, this field indicates that the programmed transfer is complete on the AHB as well as on the USB, for this endpoint.

USBOTG_DIEPTSIZn

Address: Operational Base + offset (0x0910 + 0x20 * n) $1 \leq n \leq 15$

Device endpoint n transfer size register

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved

Bit	Attr	Reset Value	Description
30:29	RW	0x0	<p>MC Multi Count Applies to IN endpoints only. For periodic IN endpoints, this field indicates the number of packets that must be transmitted per microframe on the USB. The core uses this field to calculate the data PID for isochronous IN endpoints.</p> <p>2'b01: 1 packet 2'b10: 2 packets 2'b11: 3 packets</p> <p>For non-periodic IN endpoints, this field is valid only in Internal DMA mode. It specifies the number of packets the core must fetch for an IN endpoint before it switches to the endpoint pointed to by the Next Endpoint field of the Device Endpoint-n Control register (DIEPCTLn.NextEp). Received Data PID (RxDPID)</p> <p>Applies to isochronous OUT endpoints only. This is the data PID received in the last packet for this endpoint.</p> <p>2'b00: DATA0 2'b01: DATA2 2'b10: DATA1 2'b11: MDATA</p> <p>SETUP Packet Count (SUPCnt). Applies to control OUT Endpoints only. This field specifies the number of back-to-back SETUP data packets the endpoint can receive.</p> <p>2'b01: 1 packet 2'b10: 2 packets 2'b11: 3 packets</p>

Bit	Attr	Reset Value	Description
28:19	RW	0x000	PktCnt Packet Count Indicates the total number of USB packets that constitute the Transfer Size amount of data for this endpoint. The power-on value is specified for Width of Packet Counters during IP configuration (parameter OTG_PACKET_COUNT_WIDTH). IN Endpoints: This field is decremented every time a packet (maximum size or short packet) is read from the TxFIFO. OUT Endpoints: This field is decremented every time a packet (maximum size or short packet) is written to the RxFIFO.
18:0	RW	0x00000	XferSize Transfer Size This field contains the transfer size in bytes for the current endpoint. The power-on value is specified for Width of Transfer Size Counters during IP configuration (parameter OTG_TRANS_COUNT_WIDTH). The core only interrupts the application after it has exhausted the transfer size amount of data. The transfer size can be set to the maximum packet size of the endpoint, to be interrupted at the end of each packet. IN Endpoints: The core decrements this field every time a packet from the external memory is written to the TxFIFO. OUT Endpoints: The core decrements this field every time a packet is read from the RxFIFO and written to the external memory.

USBOTG_DIEPDMA_n

Address: Operational Base + offset (0x0914 + 0x20 * n) $0 \leq n \leq 15$

Device endpoint-n DMA address register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	DMAAddr DMA Address Holds the start address of the external memory for storing or fetching endpoint data. Note: For control endpoints, this field stores control OUT data packets as well as SETUP transaction data packets. When more than three SETUP packets are received back-to-back, the SETUP data packet in the memory is overwritten. This register is incremented on every AHB transaction. The application can give only a DWORD-aligned address. When Scatter/Gather DMA mode is not enabled, the application programs the start address value in this field. When Scatter/Gather DMA mode is enabled, this field indicates the base pointer for the descriptor list.

USBOTG_DTXFSTS_n

Address: Operational Base + offset (0x0918 + 0x20 * n) 0≤n≤15

Device IN endpoint transmit FIFO status register

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved
15:0	RW	0x0000	INEPTxFSpAvail IN Endpoint TxFIFO Space Avail Indicates the amount of free space available in the Endpoint TxFIFO. Values are in terms of 32-bit words. 16'h0: Endpoint TxFIFO is full 16'h1: 1 word available 16'h2: 2 words available 16'hn: n words available (where 0 . n . 32,768) 16'h8000: 32,768 words available Others: Reserved

USBOTG_DIEPDMA_{Bn}

Address: Operational Base + offset (0x091c + 0x20 * n) 0≤n≤15

Device endpoint-n DMA buffer address register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	DMABufferAddr DMA Buffer Address Holds the current buffer address. This register is updated as and when the data transfer for the corresponding end point is in progress. This register is present only in Scatter/Gather DMA mode. Otherwise this field is reserved.

USBOTG_DIEPCTLn

Address: Operational Base + offset (0x0920 + 0x20 * n) $0 \leq n \leq 14$

Device endpoint-n control register

Bit	Attr	Reset Value	Description
31	RWSC	0x0	EPEna Endpoint Enable Applies to IN and OUT endpoints. When Scatter/Gather DMA mode is enabled, For IN endpoints this bit indicates that the descriptor structure and data buffer with data ready to transmit is setup. For OUT endpoint it indicates that the descriptor structure and data buffer to receive data is setup. When Scatter/Gather DMA mode is enabled-such as for buffer-pointer based DMA mode: For IN endpoints, this bit indicates that data is ready to be transmitted on the endpoint ; For OUT endpoints, this bit indicates that the application has allocated the memory to start receiving data from the USB. The core clears this bit before setting any of the following interrupts on this endpoint: SETUP Phase Done, Endpoint Disabled, Transfer Completed. Note: For control endpoints in DMA mode, this bit must be set to be able to transfer SETUP data packets in memory.

Bit	Attr	Reset Value	Description
30	RWSC	0x0	EPDis Endpoint Disable Applies to IN and OUT endpoints. The application sets this bit to stop transmitting/receiving data on an endpoint, even before the transfer for that endpoint is complete. The application must wait for the Endpoint Disabled interrupt before treating the endpoint as disabled. The core clears this bit before setting the Endpoint Disabled interrupt. The application must set this bit only if Endpoint Enable is already set for this endpoint.
29	WO	0x0	SetD1PID Set DATA1 PID Applies to interrupt/bulk IN and OUT endpoints only. Writing to this field sets the Endpoint Data PID (DPID) field in this register to DATA1. This field is applicable both for Scatter/Gather DMA mode and non-Scatter/Gather DMA mode. Set Odd (micro)frame (SetOddFr). Applies to isochronous IN and OUT endpoints only. Writing to this field sets the Even/Odd (micro)frame (EO_FrNum) field to odd (micro)frame. This field is not applicable for Scatter/Gather DMA mode.

Bit	Attr	Reset Value	Description
28	WO	0x0	SetDOPID Set DATA0 PID Applies to interrupt/bulk IN and OUT endpoints only. Writing to this field sets the Endpoint Data PID (DPID) field in this register to DATA0. This field is applicable both for Scatter/Gather DMA mode and non-Scatter/Gather DMA mode. In non-Scatter/Gather DMA mode: Set Even (micro)frame (SetEvenFr) Applies to isochronous IN and OUT endpoints only. Writing to this field sets the Even/Odd (micro)frame (EO_FrNum) field to even (micro)frame. When Scatter/Gather DMA mode is enabled, this field is reserved. The frame number in which to send data is in the transmit descriptor structure. The frame in which to receive data is updated in receive descriptor structure.
27	WO	0x0	SNAK Set NAK Applies to IN and OUT endpoints. A write to this bit sets the NAK bit for the endpoint. Using this bit, the application can control the transmission of NAK handshakes on an endpoint. The core can also set this bit for OUT endpoints on a Transfer Completed interrupt, or after a SETUP is received on the endpoint.
26	WO	0x0	CNAK Clear NAK Applies to IN and OUT endpoints. A write to this bit clears the NAK bit for the endpoint.

Bit	Attr	Reset Value	Description
25:22	RW	0x0	<p>TxFNum TxFIFO Number Shared FIFO Operation:non-periodic endpoints must set this bit to zero. Periodic endpoints must map this to the corresponding Periodic TxFIFO number. 4'h0: Non-Periodic TxFIFO; Others: Specified Periodic TxFIFO number. Note: An interrupt IN endpoint can be configured as a non-periodic endpoint for applications such as mass storage. The core treats an IN endpoint as a non-periodic endpoint if the TxFNum field is set to 0. Otherwise, a separate periodic FIFO must be allocated for an interrupt IN endpoint, and the number of this FIFO must be programmed into the TxFNum field. Configuring an interrupt IN endpoint as a non-periodic endpoint saves the extra periodic FIFO area. Dedicated FIFO Operation:these bits specify the FIFO number associated with this endpoint. Each active IN endpoint must be programmed to a separate FIFO number. This field is valid only for IN endpoints.</p>
21	RW	0x0	<p>Stall STALL Handshake Applies to non-control, non-isochronous IN and OUT endpoints only. The application sets this bit to stall all tokens from the USB host to this endpoint. If a NAK bit, Global Non-periodic IN NAK, or Global OUT NAK is set along with this bit, the STALL bit takes priority. Only the application can clear this bit, never the core. Applies to control endpoints only. The application can only set this bit, and the core clears it, when a SETUP token is received for this endpoint. If a NAK bit, Global Non-periodic IN NAK, or Global OUT NAK is set along with this bit, the STALL bit takes priority. Irrespective of this bit's setting, the core always responds to SETUP data packets with an ACK handshake.</p>

Bit	Attr	Reset Value	Description
20	RW	0x0	Snp Snoop Mode Applies to OUT endpoints only. This bit configures the endpoint to Snoop mode. In Snoop mode, the core does not check the correctness of OUT packets before transferring them to application memory.
19:18	RW	0x0	EPType Endpoint Type Applies to IN and OUT endpoints. This is the transfer type supported by this logical endpoint. 2'b00: Control 2'b01: Isochronous 2'b10: Bulk 2'b11: Interrupt
17	RO	0x0	NAKsts NAK Status Applies to IN and OUT endpoints. Indicates the following: 1'b0: The core is transmitting non-NAK handshakes based on the FIFO status. 1'b1: The core is transmitting NAK handshakes on this endpoint. When either the application or the core sets this bit: The core stops receiving any data on an OUT endpoint, even if there is space in the RxFIFO to accommodate the incoming packet. For non-isochronous IN endpoints: The core stops transmitting any data on an IN endpoint, even if there data is available in the TxFIFO. For isochronous IN endpoints: The core sends out a zero-length data packet, even if there data is available in the TxFIFO. Irrespective of this bit's setting, the core always responds to SETUP data packets with an ACK handshake.

Bit	Attr	Reset Value	Description
16	RO	0x0	<p>DPID Endpoint Data PID Applies to interrupt/bulk IN and OUT endpoints only. Contains the PID of the packet to be received or transmitted on this endpoint. The application must program the PID of the first packet to be received or transmitted on this endpoint, after the endpoint is activated. The applications use the SetD1PID and SetD0PID fields of this register to program either DATA0 or DATA1 PID.</p> <p>1'b0: DATA0 1'b1: DATA1</p> <p>This field is applicable both for Scatter/Gather DMA mode and non-Scatter/Gather DMA mode. Even/Odd (Micro)Frame (EO_FrNum) In non-Scatter/Gather DMA mode:</p> <p>Applies to isochronous IN and OUT endpoints only. Indicates the (micro) frame number in which the core transmits/receives isochronous data for this endpoint. The application must program the even/odd (micro) frame number in which it intends to transmit/receive isochronous data for this endpoint using the SetEvnFr and SetOddFr fields in this register.</p> <p>1'b0: Even (micro)frame 1'b1: Odd (micro)frame</p> <p>When Scatter/Gather DMA mode is enabled, this field is reserved. The frame number in which to send data is provided in the transmit descriptor structure. The frame in which data is received is updated in receive descriptor structure.</p>

Bit	Attr	Reset Value	Description
15	RWSC	0x0	USBActEP USB Active Endpoint Applies to IN and OUT endpoints. Indicates whether this endpoint is active in the current configuration and interface. The core clears this bit for all endpoints (other than EP 0) after detecting a USB reset. After receiving the SetConfiguration and SetInterface commands, the application must program endpoint registers accordingly and set this bit.
14:11	RW	0x0	NextEp Next Endpoint Applies to non-periodic IN endpoints only. Indicates the endpoint number to be fetched after the data for the current endpoint is fetched. The core can access this field, even when the Endpoint Enable (EPEna) bit is low. This field is not valid in Slave mode operation. Note: This field is valid only for Shared FIFO operations.
10:0	RW	0x000	MPS Maximum Packet Size Applies to IN and OUT endpoints. The application must program this field with the maximum packet size for the current logical endpoint. This value is in bytes.

USBOTG_DOEPCCTLn

Address: Operational Base + offset (0x0b00 + 0x20 * n) 1≤n≤15

Device control OUT endpoint 0 control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31	R/WSC	0x0	<p>EPEna Endpoint Enable When Scatter/Gather DMA mode is enabled, for OUT endpoints this bit indicates that the descriptor structure and data buffer to receive data is setup. When Scatter/Gather DMA mode is disabled?such as for buffer-pointer based DMA mode)-this bit indicates that the application has allocated the memory to start receiving data from the USB. The core clears this bit before setting any of the following interrupts on this endpoint: SETUP Phase Done, Endpoint Disabled, Transfer Completed. Note: In DMA mode, this bit must be set for the core to transfer SETUP data packets into memory.</p>
30	WO	0x0	<p>EPDis Endpoint Disable The application cannot disable control OUT endpoint 0.</p>
29:28	RO	0x0	reserved
27	WO	0x0	<p>SNAK Set NAK A write to this bit sets the NAK bit for the endpoint. Using this bit, the application can control the transmission of NAK handshakes on an endpoint. The core can also set bit on a Transfer Completed interrupt, or after a SETUP is received on the endpoint.</p>
26	WO	0x0	<p>CNAK Clear NAK A write to this bit clears the NAK bit for the endpoint.</p>
25:22	RO	0x0	reserved

Bit	Attr	Reset Value	Description
21	RWSC	0x0	<p>Stall STALL Handshake</p> <p>The application can only set this bit, and the core clears it, when a SETUP token is received for this endpoint. If a NAK bit or Global OUT NAK is set along with this bit, the STALL bit takes priority. Irrespective of this bit's setting, the core always responds to SETUP data packets with an ACK handshake.</p>
20	RW	0x0	<p>Snp Snoop Mode</p> <p>This bit configures the endpoint to Snoop mode. In Snoop mode, the core does not check the correctness of OUT packets before transferring them to application memory.</p>
19:18	RO	0x0	<p>EPType Endpoint Type</p> <p>Hardcoded to 2'b00 for control.</p>
17	RO	0x0	<p>NAKsts NAK Status</p> <p>Indicates the following:</p> <ul style="list-style-type: none"> 1'b0: The core is transmitting non-NAK handshakes based on the FIFO status. 1'b1: The core is transmitting NAK handshakes on this endpoint. <p>When either the application or the core sets this bit, the core stops receiving data, even if there is space in the RxFIFO to accommodate the incoming packet.</p> <p>Irrespective of this bit setting, the core always responds to SETUP data packets with an ACK handshake.</p>
16	RO	0x0	reserved
15	RO	0x0	<p>USBActEP USB Active Endpoint</p> <p>This bit is always set to 1, indicating that a control endpoint 0 is always active in all configurations and interfaces.</p>
14:2	RO	0x0	reserved

Bit	Attr	Reset Value	Description
1:0	RO	0x0	MPS Maximum Packet Size The maximum packet size for control OUT endpoint 0 is the same as what is programmed in control IN Endpoint 0. 2'b00: 64 bytes 2'b01: 32 bytes 2'b10: 16 bytes 2'b11: 8 bytes

USBOTG_DOEPINTn

Address: Operational Base + offset (0x0b08 + 0x20 * n) 0≤n≤15

Device endpoint-n control register

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14	W1C	0x0	NYETIntrpt NYET interrupt The core generates this interrupt when a NYET response is transmitted for a non isochronous OUT endpoint.
13	W1C	0x0	NAKIntrpt NAK interrupt The core generates this interrupt when a NAK is transmitted or received by the device. In case of isochronous IN endpoints the interrupt gets generated when a zero length packet is transmitted due to un-availability of data in the TXFifo.
12	W1C	0x0	BbleErrIntrpt BbleErr (Babble Error) interrupt The core generates this interrupt when babble is received for the endpoint.
11	W1C	0x0	PktDrpSts Packet Dropped Status This bit indicates to the application that an ISOC OUT packet has been dropped. This bit does not have an associated mask bit and does not generate an interrupt. Dependency: This bit is valid in non Scatter/Gather DMA mode when periodic transfer interrupt feature is selected.
10	RO	0x0	reserved

Bit	Attr	Reset Value	Description
9	W1C	0x0	<p>BNAIntr BNA (Buffer Not Available) Interrupt The core generates this interrupt when the descriptor accessed is not ready for the Core to process, such as Host busy or DMA done. Dependency: This bit is valid only when Scatter/Gather DMA mode is enabled.</p>
8	W1C	0x0	<p>TxfifoUndrn FIFO Underrun Applies to IN endpoints only. The core generates this interrupt when it detects a transmit FIFO underrun condition for this endpoint. Dependency: This interrupt is valid only when both of the following conditions are true: Parameter OTG_ENDED_TX_FIFO==1, Thresholding is enabled, OUT Packet Error (OutPktErr). Applies to OUT endpoints only . This interrupt is asserted when the core detects an overflow or a CRC error for an OUT packet. Dependency: This interrupt is valid only when both of the following conditions are true: Parameter OTG_ENDED_TX_FIFO==1, Thresholding is enabled.</p>
7	W1C	0x0	<p>TxFEmp Transmit FIFO Empty This bit is valid only for IN Endpoints. This interrupt is asserted when the TxFIFO for this endpoint is either half or completely empty. The half or completely empty status is determined by the TxFIFO Empty Level bit in the Core AHB Configuration register(GAHBCFG.NPTxFEmpLvl)).</p>

Bit	Attr	Reset Value	Description
6	W1C	0x0	<p>INEPNakEff IN Endpoint NAK Effective Applies to periodic IN endpoints only. This bit can be cleared when the application clears the IN endpoint NAK by writing to DIEPCTLn.CNAK. This interrupt indicates that the core has sampled the NAK bit set (either by the application or by the core). The interrupt indicates that the IN endpoint NAK bit set by the application has taken effect in the core. This interrupt does not guarantee that a NAK handshake is sent on the USB. A STALL bit takes priority over a NAK bit. This bit is applicable only when the endpoint is enabled. Back-to-Back SETUP Packets Received (Back2BackSETup) Applies to Control OUT endpoints only. This bit indicates that the core has received more than three back-to-back SETUP packets for this particular endpoint.</p>
5	W1C	0x0	<p>INTknEPMis IN Token Received with EP Mismatch Applies to non-periodic IN endpoints only. Indicates that the data in the top of the non-periodic TxFIFO belongs to an endpoint other than the one for which the IN token was received. This interrupt is asserted on the endpoint for which the IN token was received. Status Phase Received For Control Write (StsPhseRcvd) This interrupt is valid only for Control OUT endpoints and only in Scatter Gather DMA mode.</p>
4	W1C	0x0	<p>INTknTxFEmp IN Token Received When TxFIFO is Empty Indicates that an IN token was received when the associated TxFIFO periodic/nonperiodic) was empty. This interrupt is asserted on the endpoint for which the IN token was received. OUT Token Received When Endpoint Disabled (OUTTknEPdis) Indicates that an OUT token was received when the endpoint was not yet enabled. This interrupt is asserted on the endpoint for which the OUT token was received.</p>

Bit	Attr	Reset Value	Description
3	W1C	0x0	TimeOUT Timeout Condition In shared TX FIFO mode, applies to non-isochronous IN endpoints only. In dedicated FIFO mode, applies only to Control IN endpoints. In Scatter/Gather DMA mode, the TimeOUT interrupt is not asserted. Indicates that the core has detected a timeout condition on the USB for the last IN token on this endpoint. SETUP Phase Done (SetUp). Applies to control OUT endpoints only. Indicates that the SETUP phase for the control endpoint is complete and no more back-to-back SETUP packets were received for the current control transfer. On this interrupt, the application can decode the received SETUP data packet.
2	W1C	0x0	AHBErr AHB Error Applies to IN and OUT endpoints. This is generated only in Internal DMA mode when there is an AHB error during an AHB read/write. The application can read the corresponding endpoint DMA address register to get the error address.
1	W1C	0x0	EPDisbld Endpoint Disabled Interrupt Applies to IN and OUT endpoints. This bit indicates that the endpoint is disabled per the application's request.

Bit	Attr	Reset Value	Description
0	W1C	0x0	XferCompl Transfer Completed Interrupt Applies to IN and OUT endpoints. When Scatter/Gather DMA mode is enabled For IN endpoint this field indicates that the requested data from the descriptor is moved from external system memory to internal FIFO. For OUT endpoint this field indicates that the requested data from the internal FIFO is moved to external system memory. This interrupt is generated only when the corresponding endpoint descriptor is closed, and the IOC bit for the corresponding descriptor is set. When Scatter/Gather DMA mode is disabled, this field indicates that the programmed transfer is complete on the AHB as well as on the USB, for this endpoint.

USBOTG_DOEPTSIZn

Address: Operational Base + offset (0x0b10 + 0x20 * n) $1 \leq n \leq 15$

Device endpoint n transfer size register

Bit	Attr	Reset Value	Description
31	RO	0x0	reserved

Bit	Attr	Reset Value	Description
30:29	RW	0x0	<p>MC Multi Count Applies to IN endpoints only. For periodic IN endpoints, this field indicates the number of packets that must be transmitted per microframe on the USB. The core uses this field to calculate the data PID for isochronous IN endpoints.</p> <p>2'b01: 1 packet 2'b10: 2 packets 2'b11: 3 packets</p> <p>For non-periodic IN endpoints, this field is valid only in Internal DMA mode. It specifies the number of packets the core must fetch for an IN endpoint before it switches to the endpoint pointed to by the Next Endpoint field of the Device Endpoint-n Control register (DIEPCTLn.NextEp). Received Data PID (RxDPID)</p> <p>Applies to isochronous OUT endpoints only. This is the data PID received in the last packet for this endpoint.</p> <p>2'b00: DATA0 2'b01: DATA2 2'b10: DATA1 2'b11: MDATA</p> <p>SETUP Packet Count (SUPCnt). Applies to control OUT Endpoints only. This field specifies the number of back-to-back SETUP data packets the endpoint can receive.</p> <p>2'b01: 1 packet 2'b10: 2 packets 2'b11: 3 packets</p>

Bit	Attr	Reset Value	Description
28:19	RW	0x000	PktCnt Packet Count Indicates the total number of USB packets that constitute the Transfer Size amount of data for this endpoint. The power-on value is specified for Width of Packet Counters during IP configuration (parameter OTG_PACKET_COUNT_WIDTH). IN Endpoints: This field is decremented every time a packet (maximum size or short packet) is read from the TxFIFO. OUT Endpoints: This field is decremented every time a packet (maximum size or short packet) is written to the RxFIFO.
18:0	RW	0x00000	XferSize Transfer Size This field contains the transfer size in bytes for the current endpoint. The power-on value is specified for Width of Transfer Size Counters during IP configuration (parameter OTG_TRANS_COUNT_WIDTH). The core only interrupts the application after it has exhausted the transfer size amount of data. The transfer size can be set to the maximum packet size of the endpoint, to be interrupted at the end of each packet. IN Endpoints: The core decrements this field every time a packet from the external memory is written to the TxFIFO. OUT Endpoints: The core decrements this field every time a packet is read from the RxFIFO and written to the external memory.

USBOTG_DOEPDMA_n

Address: Operational Base + offset (0x0b14 + 0x20 * n) $0 \leq n \leq 15$

Device Endpoint-n DMA Address Register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	DMAAddr DMA Address Holds the start address of the external memory for storing or fetching endpoint data. Note: For control endpoints, this field stores control OUT data packets as well as SETUP transaction data packets. When more than three SETUP packets are received back-to-back, the SETUP data packet in the memory is overwritten. This register is incremented on every AHB transaction. The application can give only a DWORD-aligned address. When Scatter/Gather DMA mode is not enabled, the application programs the start address value in this field. When Scatter/Gather DMA mode is enabled, this field indicates the base pointer for the descriptor list.

USBOTG_DOEPDMABn

Address: Operational Base + offset (0x0b1c + 0x20 * n) 0≤n≤15

Device endpoint-n DMA buffer address register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	DMABufferAddr DMA Buffer Address Holds the current buffer address. This register is updated as and when the data transfer for the corresponding end point is in progress. This register is present only in Scatter/Gather DMA mode. Otherwise this field is reserved.

USBOTG_DOEPCTLn

Address: Operational Base + offset (0x0b20 + 0x20 * n) 0≤n≤14

Device endpoint-n control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31	RWSC	0x0	<p>EPEna Endpoint Enable Applies to IN and OUT endpoints. When Scatter/Gather DMA mode is enabled, For IN endpoints this bit indicates that the descriptor structure and data buffer with data ready to transmit is setup. For OUT endpoint it indicates that the descriptor structure and data buffer to receive data is setup. When Scatter/Gather DMA mode is enabled-such as for buffer-pointer based DMA mode: For IN endpoints, this bit indicates that data is ready to be transmitted on the endpoint; For OUT endpoints, this bit indicates that the application has allocated the memory to start receiving data from the USB. The core clears this bit before setting any of the following interrupts on this endpoint: SETUP Phase Done, Endpoint Disabled, Transfer Completed. Note: For control endpoints in DMA mode, this bit must be set to be able to transfer SETUP data packets in memory.</p>
30	RWSC	0x0	<p>EPDis Endpoint Disable Applies to IN and OUT endpoints. The application sets this bit to stop transmitting/receiving data on an endpoint, even before the transfer for that endpoint is complete. The application must wait for the Endpoint Disabled interrupt before treating the endpoint as disabled. The core clears this bit before setting the Endpoint Disabled interrupt. The application must set this bit only if Endpoint Enable is already set for this endpoint.</p>

Bit	Attr	Reset Value	Description
29	RO	0x0	<p>SetD1PID Field0001 Abstract Applies to interrupt/bulk IN and OUT endpoints only. Writing to this field sets the Endpoint Data PID (DPID) field in this register to DATA1. This field is applicable both for Scatter/Gather DMA mode and non-Scatter/Gather DMA mode. Set Odd (micro)frame (SetOddFr). Applies to isochronous IN and OUT endpoints only. Writing to this field sets the Even/Odd (micro)frame (EO_FrNum) field to odd (micro)frame. This field is not applicable for Scatter/Gather DMA mode.</p>
28	WO	0x0	<p>SetD0PID Set DATA0 PID Applies to interrupt/bulk IN and OUT endpoints only. Writing to this field sets the Endpoint Data PID (DPID) field in this register to DATA0. This field is applicable both for Scatter/Gather DMA mode and non-Scatter/Gather DMA mode. In non-Scatter/Gather DMA mode: Set Even (micro)frame (SetEvenFr) Applies to isochronous IN and OUT endpoints only. Writing to this field sets the Even/Odd (micro)frame (EO_FrNum) field to even (micro)frame. When Scatter/Gather DMA mode is enabled, this field is reserved. The frame number in which to send data is in the transmit descriptor structure. The frame in which to receive data is updated in receive descriptor structure.</p>
27	WO	0x0	<p>SNAK Set NAK Applies to IN and OUT endpoints. A write to this bit sets the NAK bit for the endpoint. Using this bit, the application can control the transmission of NAK handshakes on an endpoint. The core can also set this bit for OUT endpoints on a Transfer Completed interrupt, or after a SETUP is received on the endpoint.</p>

Bit	Attr	Reset Value	Description
26	WO	0x0	CNAK Clear NAK Applies to IN and OUT endpoints. A write to this bit clears the NAK bit for the endpoint.
25:22	RW	0x0	TxFNum TxFIFO Number Shared FIFO Operation:non-periodic endpoints must set this bit to zero. Periodic endpoints must map this to the corresponding Periodic TxFIFO number. 4'h0: Non-Periodic TxFIFO; Others: Specified Periodic TxFIFO number. Note: An interrupt IN endpoint can be configured as a non-periodic endpoint for applications such as mass storage. The core treats an IN endpoint as a non-periodic endpoint if the TxFNum field is set to 0. Otherwise, a separate periodic FIFO must be allocated for an interrupt IN endpoint, and the number of this FIFO must be programmed into the TxFNum field. Configuring an interrupt IN endpoint as a non-periodic endpoint saves the extra periodic FIFO area. Dedicated FIFO Operation:these bits specify the FIFO number associated with this endpoint. Each active IN endpoint must be programmed to a separate FIFO number. This field is valid only for IN endpoints.

Bit	Attr	Reset Value	Description
21	RW	0x0	<p>Stall STALL Handshake</p> <p>Applies to non-control, non-isochronous IN and OUT endpoints only. The application sets this bit to stall all tokens from the USB host to this endpoint. If a NAK bit, Global Non-periodic IN NAK, or Global OUT NAK is set along with this bit, the STALL bit takes priority. Only the application can clear this bit, never the core.</p> <p>Applies to control endpoints only. The application can only set this bit, and the core clears it, when a SETUP token is received for this endpoint. If a NAK bit, Global Non-periodic IN NAK, or Global OUT NAK is set along with this bit, the STALL bit takes priority.</p> <p>Irrespective of this bit's setting, the core always responds to SETUP data packets with an ACK handshake.</p>
20	RW	0x0	<p>Snp Snoop Mode</p> <p>Applies to OUT endpoints only. This bit configures the endpoint to Snoop mode. In Snoop mode, the core does not check the correctness of OUT packets before transferring them to application memory.</p>
19:18	RW	0x0	<p>EPType Endpoint Type</p> <p>Applies to IN and OUT endpoints. This is the transfer type supported by this logical endpoint.</p> <ul style="list-style-type: none"> 2'b00: Control 2'b01: Isochronous 2'b10: Bulk 2'b11: Interrupt

Bit	Attr	Reset Value	Description
17	RO	0x0	NAKsts NAK Status Applies to IN and OUT endpoints. Indicates the following: 1'b0: The core is transmitting non-NAK handshakes based on the FIFO status. 1'b1: The core is transmitting NAK handshakes on this endpoint. When either the application or the core sets this bit: The core stops receiving any data on an OUT endpoint, even if there is space in the RxFIFO to accommodate the incoming packet.

Bit	Attr	Reset Value	Description
16	RO	0x0	<p>DPID Endpoint Data PID Applies to interrupt/bulk IN and OUT endpoints only. Contains the PID of the packet to be received or transmitted on this endpoint. The application must program the PID of the first packet to be received or transmitted on this endpoint, after the endpoint is activated. The applications use the SetD1PID and SetDOPID fields of this register to program either DATA0 or DATA1 PID.</p> <p>1'b0: DATA0 1'b1: DATA1</p> <p>This field is applicable both for Scatter/Gather DMA mode and non-Scatter/Gather DMA mode. Even/Odd (Micro)Frame (EO_FrNum). In non-Scatter/Gather DMA mode: Applies to isochronous IN and OUT endpoints only. Indicates the (micro)frame number in which the core transmits/receives isochronous data for this endpoint. The application must program the even/odd (micro) frame number in which it intends to transmit/receive isochronous data for this endpoint using the SetEvnFr and SetOddFr fields in this register.</p> <p>1'b0: Even (micro)frame 1'b1: Odd (micro)frame</p> <p>When Scatter/Gather DMA mode is enabled, this field is reserved. The frame number in which to send data is provided in the transmit descriptor structure. The frame in which data is received is updated in receive descriptor structure.</p>

Bit	Attr	Reset Value	Description
15	RWSC	0x0	USBActEP USB Active Endpoint Applies to IN and OUT endpoints. Indicates whether this endpoint is active in the current configuration and interface. The core clears this bit for all endpoints (other than EP 0) after detecting a USB reset. After receiving the SetConfiguration and SetInterface commands, the application must program endpoint registers accordingly and set this bit.
14:11	RW	0x0	NextEp Next Endpoint Applies to non-periodic IN endpoints only. Indicates the endpoint number to be fetched after the data for the current endpoint is fetched. The core can access this field, even when the Endpoint Enable (EPEna) bit is low. This field is not valid in Slave mode operation. Note: This field is valid only for Shared FIFO operations.
10:0	RW	0x000	MPS Maximum Packet Size Applies to IN and OUT endpoints. The application must program this field with the maximum packet size for the current logical endpoint. This value is in bytes.

USBOTG_PCGCR

Address: Operational Base + offset (0x0b24)

Power and clock gating control register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:14	RW	0x0802e	<p>RestoreValue Restore Value (Applicable only when Hibernation is enabled (OTG_EN_PWRLOPT=2). Defines port clock select for different speeds.</p> <ul style="list-style-type: none"> [31] if_dev_mode <ul style="list-style-type: none"> - 1: Device mode, core restored as device - 0: Host mode, core restored as host [30:29] p2hd_prt_spd (PRT speed) <ul style="list-style-type: none"> - 00: HS - 01: FS - 10: LS - 11: Reserved [28:27] p2hd_dev_enum_spd (Device enumerated speed) <ul style="list-style-type: none"> - 00: HS - 01: FS (30/60 MHz clk) - 10: LS - 11: FS (48 MHz clk) [26:20] mac_dev_addr (MAC device address) Device address [19] mac_termselect (Termination selection) <ul style="list-style-type: none"> - 0: HS_TERM (Program for High Speed) - 1: FS_TERM (Program for Full Speed) [18:17] mac_xcvrselect (Transceiver select) <ul style="list-style-type: none"> - 00: HS_XCVR (High Speed) - 01: FS_XCVR (Full Speed) - 10: LS_XCVR (Low Speed) - 11: LFS_XCVR (Reserved) [16] sh2pl_prt_ctl[0] <ul style="list-style-type: none"> - 1: prt_power enabled - 0: prt_power disabled [15:14] prt_clk_sel (Refer prt_clk_sel table)
13	RW	0x0	<p>EssRegRestored Essential Register Values Restored (Applicable only when Hibernation is enabled (OTG_EN_PWRLOPT=2). When a value of 1 is written to this field, it indicates that register values of essential registers have been restored.</p>
12:10	RO	0x0	reserved

Bit	Attr	Reset Value	Description
9	RO	0x0	<p>RestoreMode Restore Mode (Applicable only when Hibernation is enabled (OTG_EN_PWR OPT=2). The application should program this bit to specify the restore mode during RESTORE POINT before programming PCGCCTL.EssRegRest bit is set.</p> <p>Host Mode: 1'b0: Host Initiated Resume, Host Initiated Reset 1'b1: Device Initiated Remote Wake up</p> <p>Device Mode: 1'b0: Device Initiated Remote Wake up 1'b1: Host Initiated Resume, Host Initiated Reset</p>
8	RW	0x0	<p>ResetAfterSusp Reset After Suspend Applicable in Partial power-down mode. In partial power-down mode of operation, this bit needs to be set in host mode before clamp is removed if the host needs to issue reset after suspend. If this bit is not set, then the host issues resume after suspend. This bit is not applicable in device mode and non-partial power-down mode. In Hibernation mode, this bit needs to be set at RESTORE_POINT before PCGCCTL.EssRegRestored is set. In this case, PCGCCTL.restore_mode needs to be set to wait_restore.</p>
7	RO	0x0	<p>L1Suspended Deep Sleep This bit indicates that the PHY is in deep sleep when in L1 state.</p>
6	RO	0x0	<p>PhySleep PHY in Sleep This bit indicates that the PHY is in the Sleep state.</p>
5	RW	0x0	<p>Enbl_L1Gating Enable Sleep Clock Gating When this bit is set, core internal clock gating is enabled in Sleep state if the core cannot assert utmi_l1_suspend_n. When this bit is not set, the PHY clock is not gated in Sleep state.</p>

Bit	Attr	Reset Value	Description
4	RO	0x0	reserved
3	RW	0x0	RstPdwnModule Reset Power-Down Modules This bit is valid only in Partial Power-Down mode. The application sets this bit when the power is turned off. The application clears this bit after the power is turned on and the PHY clock is up.
2	RW	0x0	PwrClmp Power Clamp This bit is valid only in Partial Power-Down mode (OTG_EN_PWR0OPT = 1). The application sets this bit before the power is turned off to clamp the signals between the power-on modules and the power-off modules. The application clears the bit to disable the clamping before the power is turned on.
1	RW	0x0	GateHclk Gate Hclk The application sets this bit to gate hclk to modules other than the AHB Slave and Master and wakeup logic when the USB is suspended or the session is not valid. The application clears this bit when the USB is resumed or a new session starts.
0	RW	0x0	StopPclk Stop Pclk The application sets this bit to stop the PHY clock (phy_clk) when the USB is suspended, the session is not valid, or the device is disconnected. The application clears this bit when the USB is resumed or a new session starts.

USB_EPBUFO

Address: Operational Base + offset (0x1000)

Device endpoint 0 / host out channel 0 address

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUFO Device endpoint 0 / host out channel 0 address Device IN Endpoint 0 / Host OUT Channel 0: DFIFO Write Access Device OUT Endpoint 0 / Host IN Channel 0: DFIFO Read Access

USB_EPBUF1

Address: Operational Base + offset (0x2000)
Device endpoint 1 / host out channel 1 address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUF1 Device endpoint 1 / host out channel 1 address Device IN Endpoint 1/Host OUT Channel 1: DFIFO Write Access Device OUT Endpoint 1/Host IN Channel 1: DFIFO Read Access

USB_EPBUF2

Address: Operational Base + offset (0x3000)
Device endpoint 2 / host out channel 2 address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUF2 Device endpoint 2 / host out channel 2 address Device IN Endpoint 2/Host OUT Channel 2: DFIFO Write Access Device OUT Endpoint 2/Host IN Channel 2: DFIFO Read Access

USB_EPBUF3

Address: Operational Base + offset (0x4000)
Device endpoint 3 / host out channel 3 address

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUF3 Device endpoint 3 / host out channel 3 address Device IN Endpoint 3/Host OUT Channel 3: DFIFO Write Access Device OUT Endpoint 3/Host IN Channel 3: DFIFO Read Access

USB_EPBUF4

Address: Operational Base + offset (0x5000)
Device endpoint 4 / host out channel 4 address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUF4 Device endpoint 4 / host out channel 4 address Device IN Endpoint 4/Host OUT Channel 4: DFIFO Write Access Device OUT Endpoint 4/Host IN Channel 4: DFIFO Read Access

USB_EPBUFS

Address: Operational Base + offset (0x6000)
Device endpoint 5 / host out channel 5 address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUF5 Device endpoint 5 / host out channel 5 address Device IN Endpoint 5/Host OUT Channel 5: DFIFO Write Access Device OUT Endpoint 5/Host IN Channel 5: DFIFO Read Access

USB_EPBUF6

Address: Operational Base + offset (0x7000)
Device endpoint 6 / host out channel 6 address

Bit	Attr	Reset Value	Description

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUF6 Device endpoint 6 / host out channel 6 address Device IN Endpoint 6/Host OUT Channel 6: DFIFO Write Access Device OUT Endpoint 6/Host IN Channel 6: DFIFO Read Access

USB_EPBUF7

Address: Operational Base + offset (0x8000)
Device endpoint 7 / host out channel 7 address

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	EPBUF7 Device endpoint 7 / host out channel 7 address Device IN Endpoint 7/Host OUT Channel 7: DFIFO Write Access Device OUT Endpoint 7/Host IN Channel 7: DFIFO Read Access

26.6 Interface description

Table 26- 2 USB OTG 2.0 Interface Description

Module Pin	Direction	Pad Name	pinmux
OTG_VSSAC	AG	OTG_VSSAC	-
OTG_DVSS	DG	OTG_DVSS	-
OTG_DVDD	DP	OTG_DVDD	-
OTG_VDD25	AP	OTG_VDD25	-
OTG_DM	A	OTG_DM	-
OTG_RKELVIN	A	OTG_RKELVIN	-
OTG_DP	A	OTG_DP	-
OTG_VSSA	AG	OTG_VSSA	-
OTG_VBUS	A	OTG_VBUS	-
OTG_VDD33	AP	OTG_VDD33	-
OTG_ID	A	OTG_ID	-
otg_drv_vbus	O	GPIO0_A[5]	GRF_GPIO0A_IOMUX [10]=1

Note: **A**—Analog pad ; **AP**—Analog power; **AG**—Analog ground ;**DP**—Digital power ; **DG**—Digital ground;

Chapter 27 GPS

27.1 Overview

The GPS is a high-performance baseband device which has an ahb master interface and an ahb slave interface. The CPU can access GPS registers through the ahb slave interface. The GPS has a 32-channel DMA inside, which can read/write data to system memory through the ahb master interface.

27.1.1 Features

- single chip, integrate GPS bb with cpu.
- 32 DMA channels for ahb master access
- complete L1-band, C/A, and NMEA-0183 compatibility.
- support reference frequencies 16.368MHz.
- high sensitivity for indoor fixes.
- low power consumption.
- low cost with smaller size.
- multi modes support both standalone GPS and A_GPS

27.2 Block Diagram

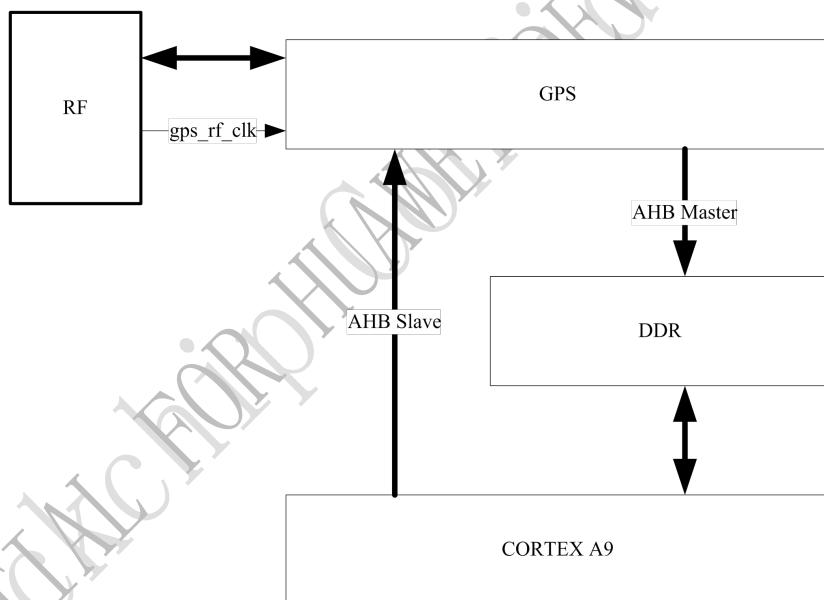


Fig. 27-1 GPS block diagram

As shown in Fig. 18-1, the GPS controller should be connected to RF chip through IO. The RF chip has 3 1-bit signal output to GPS controller inside chip. They are GPS_RF_CLK, GPS_SIG, GPS_MAG. The CPU can start RF chip through GPIO, after GPS configuring completion.

27.3 Register Summary

27.3.1 Base band register summary

Name	Offset	Size	Reset Value	Description
BB_CTRL	0x400	W	0x0	base band control register
BB_START_ADR	0x404	W	0x0	correlator start address register
BB_DS_PARAMETER	0x408	W	0x0	down-sample control register
GPS_INT_ENA	0x40c	W	0x0	interrupt enable register

Name	Offset	Size	Reset Value	Description
GPS_INT_STATUS	0x410	W	0x0	interrupt status register
BB_CHN_COR_STATUS	0x414	W	0x0	channel correlator status register
BB_CHN_COR_VALID	0x418	W	0x0	channel correlator valid register
BB_RF_TIMER_VAL	0x41c	W	0x0	RF clock timer value register
BB_RF_WT_ADDR	0x420	W	0x1fffffff	RF FIFO write address register
CH_MISCx	x<<5+0	W	N/A	control information
CH_CAR_NCOx	x<<5+4	W	N/A	carrier NCO
CH_CODE_NCOx	x<<5+8	W	N/A	code NCO
CH_DMA_ADDRx	x<<5+12	W	N/A	dma address
CH_CAR_FREQx	x<<5+16	W	N/A	carrier frequency
CH_CODE_FREQx	x<<5+20	W	N/A	carrier frequency

x is for the channel number from 0-31

27.3.2 ACC operation register

Name	Offset	Size	Reset Value	Description
ACC_CTRL	0x8000	W	0x0	acc control register
DMA_CH0_START_ADDR	0x8004	W	0xffffffff	channel 0 dma start address
DMA_CH1_START_ADDR	0x800c	W	0aaaaaaaaa	channel 1 dma start address
DMA_CH2_START_ADDR	0x8014	W	0x55555555	channel 2 dma start address
FFT_VLD_NUM_START_P OINT	0x801c	W	0x0	FFT_START_POINT,FFT_VALID_NUM
FFT_COR_NUM_LOOP_N UM	0x8020	W	0x0	FFT_LOOP_NUM,TOT_EPD_COR_NUM,EPD_START_COR_NUM
EPD_MAXCORID	0x8024	W	0x0	EPD_MAXCORID, MAX_FREQINDEX
EPD_MAX_DATA_MAN	0x8028	W	0x0	the maximum energy mantissa
EPD_MAX_DATA_EXP	0x802c	W	0x0	the exponent of the maximum energy
EPD_MAX_RIGHT_MAN	0x8030	W	0x0	the mantissa of the right data to the max energy
EPD_MAX_RIGHT_EXP	0x8034	W	0x0	the exponent of the right data to the max energy
EPD_MAX_LEFT_MAN	0x8038	W	0x0	the mantissa of the left data to the max energy
EPD_MAX_LEFT_EXP	0x803c	W	0x0	the exponent of the left data to the max energy
EPD_L0_DATA_MAN	0x8040	W	0x0	the mantissa of the max energy of the cor0 data
EPD_L0_DATA_EXP	0x8044	W	0x0	the exponent of the max energy of the cor0 data
EPD_L1_DATA_MAN	0x8048	W	0x0	the mantissa of the max energy of the cor1 data
EPD_L1_DATA_EXP	0x804c	W	0x0	the exponent of the max energy of the cor1 data
EPD_L2_DATA_MAN	0x8050	W	0x0	the mantissa of the max energy of the cor2 data
EPD_L2_DATA_EXP	0x8054	W	0x0	the exponent of the max energy of the cor2 data
EPD_L3_DATA_MAN	0x8058	W	0x0	the mantissa of the max energy of the cor3 data

Name	Offset	Size	Reset Value	Description
EPD_L3_DATA_EXP	0x805c	W	0x0	the exponent of the max energy of the cor3 data
EPD_L4_DATA_MAN	0x8060	W	0x0	the mantissa of the max energy of the cor4 data
EPD_L4_DATA_EXP	0x8064	W	0x0	the exponent of the max energy of the cor4 data
EPD_L5_DATA_MAN	0x8068	W	0x0	the mantissa of the max energy of the cor5 data
EPD_L5_DATA_EXP	0x806c	W	0x0	the exponent of the max energy of the cor5 data
EPD_L6_DATA_MAN	0x8070	W	0x0	the mantissa of the max energy of the cor6 data
EPD_L6_DATA_EXP	0x8074	W	0x0	the exponent of the max energy of the cor6 data
EPD_L7_DATA_MAN	0x8078	W	0x0	the mantissa of the max energy of the cor7 data
EPD_L7_DATA_EXP	0x807c	W	0x0	the exponent of the max energy of the cor7 data
EPD_L8_DATA_MAN	0x8080	W	0x0	the mantissa of the max energy of the cor8 data
EPD_L8_DATA_EXP	0x8084	W	0x0	the exponent of the max energy of the cor8 data
EPD_L9_DATA_MAN	0x8088	W	0x0	the mantissa of the max energy of the cor9 data
EPD_L9_DATA_EXP	0x808c	W	0x0	the exponent of the max energy of the cor9 data

27.3.3 GPS Controller IOMUX

The GPS Controller share the pin with I2S IO. In default, the pins are used for GPIO, if user want to work in GPS function, the user must configure the GRF registers as following table:

Table 27- 1 GPS IOMUX Settings

Module Pin	Direction	Pad Name	IOMUX Setting
gps_clk	I	GPIO1_A[2]	GPIO1A_IOMUX[5:4]=2'b10& GPIO1A_IOMUX[21:20]=2'b11
gps_mag	I	GPIO1_A[4]	GPIO4B_IOMUX[9:8]=2'b10& GPIO4B_IOMUX[25:24]=2'b11
gps_sign	I	GPIO1_A[5]	GPIO4B_IOMUX[11:10]=2'b10& GPIO4B_IOMUX[27:26]=2'b11

27.3.4 GPSTiming

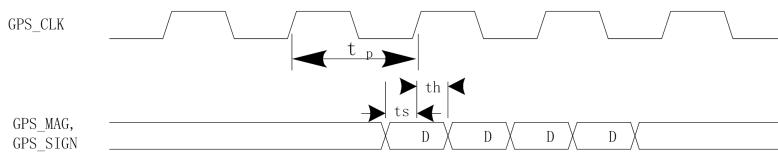


Fig. 27- 2GPS timing waveform

symbol	parameter	Min	Max	Unit
tp	clock period	33.3	100	ns
ts	setup time	23.3	-	ns
th	hold time	1.7	-	ns

Chapter 28 I2S/PCM Controller (2 channel)

28.1 Overview

The I2S/PCM controller is designed for interfacing between the AHB bus and the I2S bus.

The I2S bus (Inter-IC sound bus) is a serial link for digital audio data transfer between devices in the system and was invented by Philips Semiconductor. Now it is widely used by many semiconductor manufacturers.

Devices often use the I2S bus are ADC, DAC, DSP, CPU, etc. With the I2S interface, we can connect audio devices and the embedded SoC platform together and provide an audio interface solution for the system.

Not only I2S but also PCM mode stereo audio output and input are supported in I2S/PCM1/2 controller.

- Support two internal 32-bit wide and 32-location deep FIFOs, one for transmitting and the other for receiving audio data
- Support AHB bus interface
- Support 16 ~ 32 bits audio data transfer
- Support master and slave mode
- Support DMA handshake interface and configurable DMA water level
- Support transmit FIFO empty, underflow, receive FIFO full, overflow interrupt and all interrupts can be masked
- Support configurable water level of transmit FIFO empty and receive FIFO full interrupt
- Support combine interrupt output
- Support 2 channels audio transmitting in I2S mode but 2,4,6,8 channels in PCM mode
- Support 2 channels audio receiving in I2S and PCM mode
- Support up to 192kHz sample rate
- Support I2S normal, left and right justified mode serial audio data transfer
- Support PCM early, late1, late2, late3 mode serial audio data transfer
- Support MSB or LSB first serial audio data transfer
- Support 16 to 31 bit audio data left or right justified in 32-bit wide FIFO
- Support two 16-bit audio data store together in one 32-bit wide location
- Support 2 independent LRCK signals, one for receiving and the other for transmitting audio data
- Support configurable SCLK and LRCK polarity
- Support SCLK is equivalent to MCLK divided by an even number range from 2 to 64 in master mode

28.2 Block Diagram

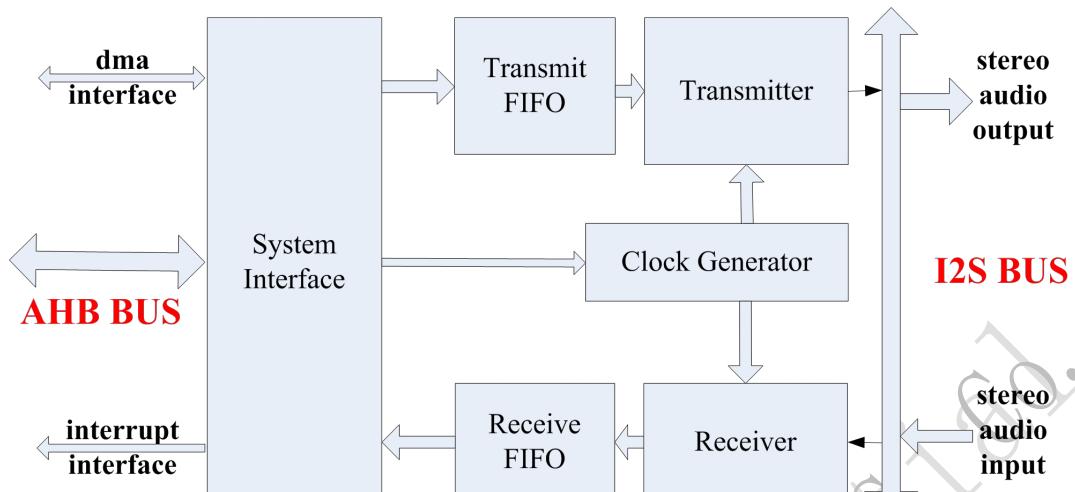


Fig. 28-1 I2S/PCM1/2 controller (2 channel) Block Diagram

System Interface

The system interface implements the AHB slave operation. It contains not only control registers of transmitters and receiver inside but also interrupt and DMA handshake interface.

Clock Generator

The Clock Generator implements clock generation function. The input source clock to the module is MCLK_I2S, and by the divider of the module, the clock generator generates SCLK and LRCK to transmitter and receiver.

Transmitters

The Transmitters implement transmission operation. The transmitters can act as either master or slave, with I2S or PCM mode surround (up to 7.1 channel) serial audio interface.

Receiver

The Receiver implements receive operation. The receiver can act as either master or slave, with I2S or PCM mode stereo serial audio interface.

Transmit FIFO

The Transmit FIFO is the buffer to store transmitted audio data. The size of the FIFO is 32bits x 32.

Receive FIFO

The Receive FIFO is the buffer to store received audio data. The size of the FIFO is 32bits x 32.

28.3 Function description

In the I2S/PCM1/2 controller, there are four conditions: transmitter-master & receiver-master; transmitter-master & receiver-slave; transmitter-slave & receiver-master; transmitter-slave & receiver-slave.

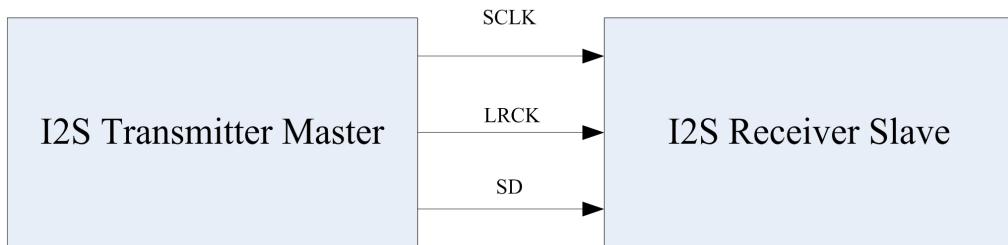


Fig. 28- 2I2S transmitter-master & receiver-slave condition

When transmitter acts as a master, it sends all signals to receiver (slave), and CPU control when to send clock and data to the receiver. When acting as a slave, SD signal still goes from transmitter to receiver, but SCLK and LRCK signals are from receiver (master) to transmitter. Based on three interface specifications, transmitting data should be ready before transmitter receives SCLK and LRCK signals. CPU should know when the receiver to initialize a transaction and when to send data.

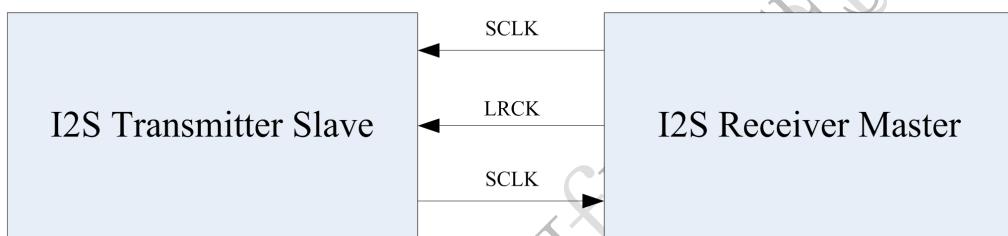


Fig. 28- 3I2S transmitter-slave & receiver-master condition

When the receiver acts as a master, it sends SCLK and LRCK signals to the transmitter (slave) and receives serial data. So CPU must tell the transmitter when to start a transaction for it to prepare transmitting data then start a transfer and send clock and channel-select signals. When the receiver acts as a slave, CPU should only do initial setting and wait for all signals and then start reading data.

Before transmitting or receiving data, CPU need do initial setting to the I2S register. These includes CPU settings, I2S interface registers settings, and maybe the embedded SoC platform settings. These registers must be set before starting data transfer.

28.3.1 I2S normal mode

This is the waveform of I2S normal mode. For LRCK (i2s1_lrck_rx/i2s1_lrck_tx) signal, it goes low to indicate left channel and high to right channel. For SD (i2s1_sdo, i2s1_sdi) signal, it transfers MSB or LSB first and sends the first bit one SCLK clock cycle after LRCK changes. The range of SD signal width is from 16 to 32bits.

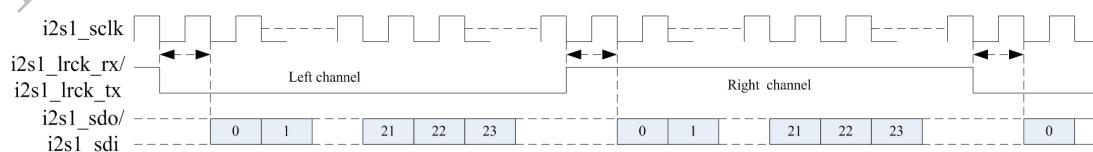


Fig. 28- 4I2S normal mode timing format

28.3.2 I2S left justified mode

This is the waveform of I2S left justified mode. For LRCK (i2s1_lrck_rx / i2s1_lrck_tx) signal, it goes high to indicate left channel and low to right channel.

For SD (i2s1_sdo, i2s1_sdi) signal, it transfers MSB or LSB first and sends the first bit at the same time when LRCK changes. The range of SD signal width is from 16 to 32bits.

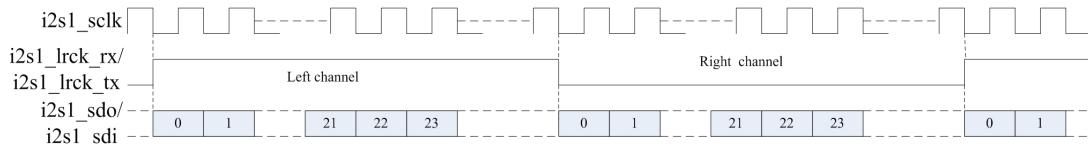


Fig. 28- 5I2S left justified mode timing format

28.3.3 I2S right justified mode

This is the waveform of I2S right justified mode. For LRCK (i2s1_lrck_rx/i2s1_lrck_tx) signal, it goes high to indicate left channel and low to right channel. For SD (i2s1_sdo, i2s1_sdi) signal, it transfers MSB or LSB first; but different from I2S normal or left justified mode, its data is aligned to last bit at the edge of the LRCK signal. The range of SD signal width is from 16 to 32bits.

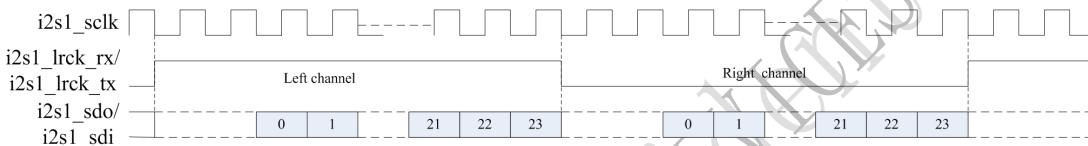


Fig. 28- 6I2S right justified mode timing format

28.3.4 PCM early mode

This is the waveform of PCM early mode. For LRCK (i2s1_lrck_rx/i2s1_lrck_tx) signal, it goes high to indicate the start of a group of audio channels. For SD (i2s1_sdo, i2s1_sdi) signal, it transfers MSB or LSB first and sends the first bit at the same time when LRCK goes high. The range of SD signal width is from 16 to 32bits.

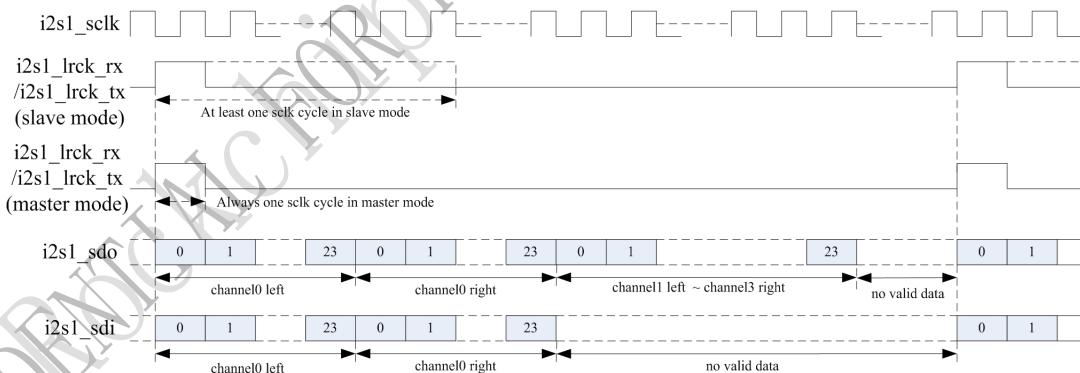


Fig. 28- 7PCM early mode timing format

28.3.5 PCM late1 mode

This is the waveform of PCM early mode. For LRCK (i2s1_lrck_rx/i2s1_lrck_tx) signal, it goes high to indicate the start of a group of audio channels. For SD (i2s1_sdo, i2s1_sdi) signal, it transfers MSB or LSB first and sends the first bit one SCLK clock cycle after LRCK goes high. The range of SD signal width is from 16 to 32bits.

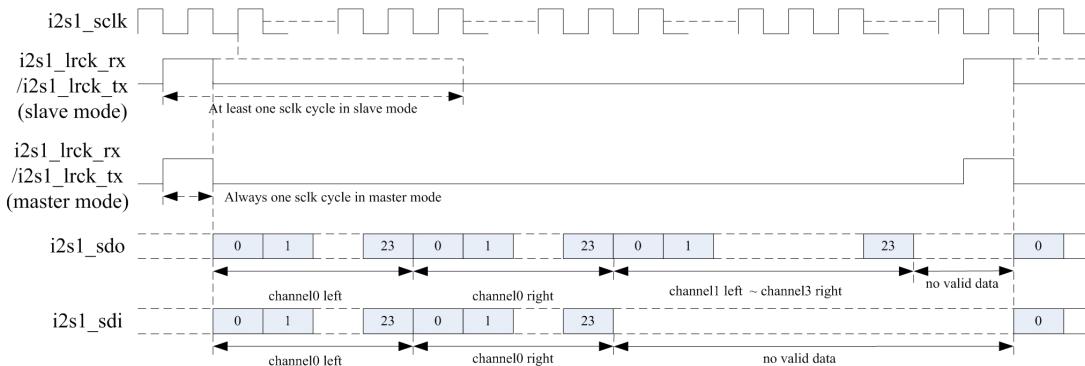


Fig. 28- 8PCM late1 mode timing format

28.3.6 PCM late2 mode

This is the waveform of PCM early mode. For LRCK (i2s1_lrck_rx/i2s1_lrck_tx) signal, it goes high to indicate the start of a group of audio channels. For SD (i2s1_sdo, i2s1_sdi) signal, it transfers MSB or LSB first and sends the first bit two SCLK clock cycles after LRCK goes high. The range of SD signal width is from 16 to 32bits.

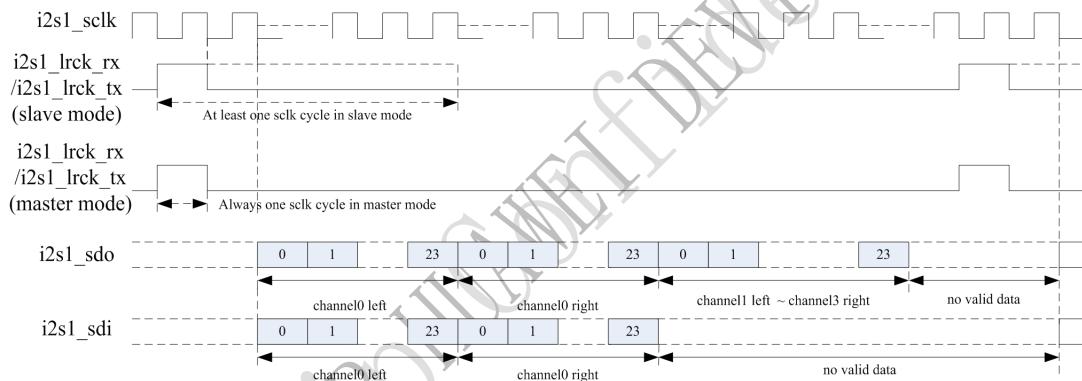


Fig. 28- 9PCM late2 mode timing format

28.3.7 PCM late3 mode

This is the waveform of PCM early mode. For LRCK (i2s1_lrck_rx/i2s1_lrck_tx) signal, it goes high to indicate the start of a group of audio channels. For SD (i2s1_sdo, i2s1_sdi) signal, it transfers MSB or LSB first and sends the first bit three SCLK clock cycles after LRCK goes high. The range of SD signal width is from 16 to 32bits.

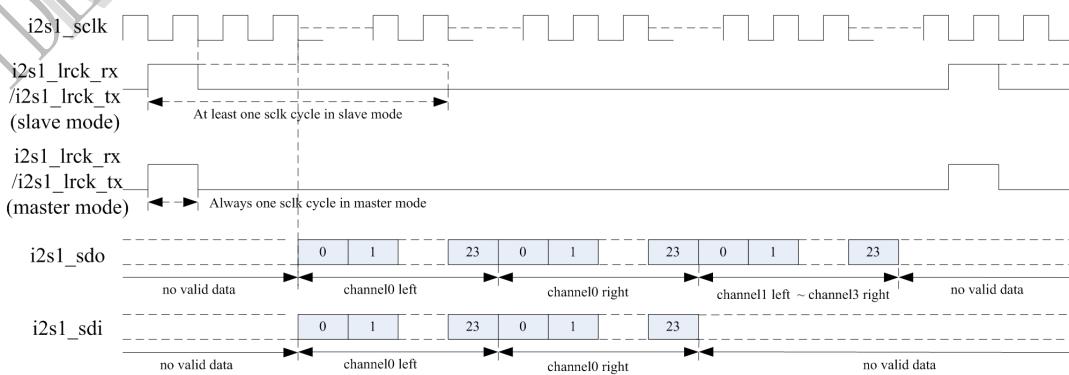


Fig. 28- 10PCM late3 mode timing format

28.4 Register description

28.4.1 Register Summary

Name	Offset	Size	Reset Value	Description
I2Sx_TXCR	0x0000	W	0x0000000f	transmit operation control register
I2Sx_RXCR	0x0004	W	0x0000000f	receive operation control register
I2Sx_CKR	0x0008	W	0x00071f1f	clock generation register
I2Sx_FIFOLR	0x000c	W	0x00000000	FIFO level register
I2Sx_DMACR	0x0010	W	0x001f0000	DMA control register
I2Sx_INTCR	0x0014	W	0x00000000	interrupt control register
I2Sx_INTSR	0x0018	W	0x00000000	interrupt status register
I2Sx_XFER	0x001c	W	0x00000000	Transfer Start Register
I2Sx_CLR	0x0020	W	0x00000000	SCLK domain logic clear Register
I2Sx_TXDR	0x0400 ~0x7FC	W	0x00000000	Transimt FIFO Data Register
I2Sx_RXDR	0x0800 ~0xBFC	W	0x00000000	Receive FIFO Data Register

Notes: Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access, x=1,2

28.4.2 Detail Register Description

I2Sx_TXCR

Address: Operational Base + offset (0x0000)
transmit operation control register

Bit	Attr	Reset Value	Description
31:23	RO	0x0	reserved
22:17	RW	0x00	RCNT right jusitified counter (Can be written only when XFER[0] bit is 0.) Only vailid in I2S Right justified format and slave tx mode is selected. Start to tramsmit data RCNT sclk cycles after left channel valid.
16:15	RW	0x0	CSR Channel select register Must be 2'b00.
14	RW	0x0	HWT Halfword word transform (Can be written only when XFER[0] bit is 0.) Only valid when VDW select 16bit data. 0:low 16bit data valid from AHB/APB bus. 1:32 bit data valid from AHB/APB bus. Low 16 bit for left channel and high 16 bit for right channel.

Bit	Attr	Reset Value	Description
13	RO	0x0	reserved
12	RW	0x0	SJM Store justified mode (Can be written only when XFER[0] bit is 0.) 16bit~31bit DATA stored in 32 bits width fifo. If VDW select 16bit data, this bit is valid only when HWT select 0.Because if HWT is 1, every fifo unit contain two 16bit data and 32 bit space is full, it is impossible to choose justified mode. 0:right justified 1:left justified
11	RW	0x0	FBM First Bit Mode (Can be written only when XFER[0] bit is 0.) 0:MSB 1:LSB
10:9	RW	0x0	IBM I2S bus mode (Can be written only when XFER[0] bit is 0.) 0:I2S normal 1:I2S Left justified 2:I2S Right justified 3:reserved
8:7	RW	0x0	PBM PCM bus mode (Can be written only when XFER[0] bit is 0.) 0:PCM no delay mode 1:PCM delay 1 mode 2:PCM delay 2 mode 3:PCM delay 3 mode
6	RO	0x0	reserved
5	RW	0x0	TFS Transfer format select (Can be written only when XFER[0] bit is 0.) 0: I2S format 1: PCM format

Bit	Attr	Reset Value	Description
4:0	RW	0x0f	VDW Valid Data width (Can be written only when XFER[0] bit is 0.) 0~14:reserved 15:16bit 16:17bit 17:18bit 18:19bit 28:29bit 29:30bit 30:31bit 31:32bit

I2Sx_RXCR

Address: Operational Base + offset (0x0004)
 receive operation control register

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14	RW	0x0	HWT Halfword word transform (Can be written only when XFER[1] bit is 0.) Only valid when VDW select 16bit data. 0:low 16bit data valid from AHB/APB bus. 1:32 bit data valid from AHB/APB bus. Low 16 bit for left channel and high 16 bit for right channel.
13	RO	0x0	reserved
12	RW	0x0	SJM Store justified mode (Can be written only when XFER[1] bit is 0.) 16bit~31bit DATA stored in 32 bits width fifo. If VDW select 16bit data, this bit is valid only when HWT select 0.Because if HWT is 1, every fifo unit contain two 16bit data and 32 bit space is full, it is impossible to choose justified mode. 0:right justified 1:left justified

Bit	Attr	Reset Value	Description
11	RW	0x0	FBM First Bit Mode (Can be written only when XFER[1] bit is 0.) 0:MSB 1:LSB
10:9	RW	0x0	IBM I2S bus mode (Can be written only when XFER[1] bit is 0.) 0:I2S normal 1:I2S Left justified 2:I2S Right justified 3:reserved
8:7	RW	0x0	PBM PCM bus mode (Can be written only when XFER[1] bit is 0.) 0:PCM no delay mode 1:PCM delay 1 mode 2:PCM delay 2 mode 3:PCM delay 3 mode
6	RO	0x0	reserved
5	RW	0x0	TFS Transfer format select (Can be written only when XFER[1] bit is 0.) 0:i2s 1:pcm
4:0	RW	0x0f	VDW Valid Data width (Can be written only when XFER[1] bit is 0.) 0~14:reserved 15:16bit 16:17bit 17:18bit 18:19bit 28:29bit 29:30bit 30:31bit 31:32bit

I2Sx_CKR

Address: Operational Base + offset (0x0008)
clock generation register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:28	RO	0x0	reserved
27	RW	0x0	MSS Master/slave mode select (Can be written only when XFER[1] or XFER[0] bit is 0.) 0:master mode(sclk output) 1:slave mode(sclk input)
26	RW	0x0	CKP Sclk polarity (Can be written only when XFER[1] or XFER[0] bit is 0.) 0: sample data at posedge sclk and drive data at negedge sclk 1: sample data at negedge sclk and drive data at posedge sclk
25	RW	0x0	RLP Receive Irck polarity (Can be written only when XFER[1] or XFER[0] bit is 0.) 0:normal polartiy (I2S normal: low for left channel, high for right channel) I2S left/right just: high for left channel, low for right channel PCM start signal:high valid) 1:oppsite polarity (I2S normal: high for left channel, low for right channel) I2S left/right just: low for left channel, high for right channel PCM start signal:low valid)

Bit	Attr	Reset Value	Description
24	RW	0x0	<p>TLP Transmit Irck polarity (Can be written only when XFER[1] or XFER[0] bit is 0.) 0: normal polartiy (I2S normal: low for left channel, high for right channel I2S left/right just: high for left channel, low for right channel PCM start signal:high valid) 1: oppsite polarity (I2S normal: high for left channel, low for right channel I2S left/right just: low for left channel, high for right channel PCM start signal:low valid)</p>
23:16	RW	0x07	<p>MDIV mclk divider (Can be written only when XFER[1] or XFER[0] bit is 0.) Serial Clock Divider = Fmclk / Ftxsclk-1.(mclk frequency / txsclk frequency-1) 0 :Fmclk=Ftxsclk; 1 :Fmclk=2*Ftxsclk; 2,3 :Fmclk=4*Ftxsclk; 4,5 :Fmclk=6*Ftxsclk; 60,61:Fmclk=62*Ftxsclk; 62,63:Fmclk=64*Ftxsclk; 252,253:Fmclk=254*Ftxsclk; 254,255:Fmclk=256*Ftxsclk;</p>

Bit	Attr	Reset Value	Description
15:8	RW	0x1f	<p>RSD Receive sclk divider (Can be written only when XFER[1] or XFER[0] bit is 0.) Receive sclk divider= Fsclk/Frxlrck 0~30:reserved 31: 32fs 32: 33fs 33: 34fs 34: 35fs 253: 254fs 254: 255fs 255: 256fs</p>
7:0	RW	0x1f	<p>TSD Transmit sclk divider (Can be written only when XFER[1] or XFER[0] bit is 0.) Transmit sclk divider=Ftxsclk/Ftxlrck 0~30:reserved 31: 32fs 32: 33fs 33: 34fs 34: 35fs 253: 254fs 254: 255fs 255: 256fs</p>

I2Sx_FIFOLR

Address: Operational Base + offset (0x000c)

FIFO level register

Bit	Attr	Reset Value	Description
31:30	RO	0x0	reserved
29:24	RO	0x00	<p>RFL Receive FIFO Level Contains the number of valid data entries in the receive FIFO.</p>
23:6	RO	0x0	reserved
5:0	RO	0x00	<p>TFL Transmit FIFO Level Contains the number of valid data entries in the transmit FIFO0.</p>

I2Sx_DMCR

Address: Operational Base + offset (0x0010)

DMA control register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved
24	RW	0x0	RDE Receive DMA Enable 0 : Receive DMA disabled 1 : Receive DMA enabled
23:21	RO	0x0	reserved
20:16	RW	0x1f	RDL Receive Data Level This bit field controls the level at which a DMA request is made by the receive logic. The watermark level = DMARDL+1; that is, dma_rx_req is generated when the number of valid data entries in the receive FIFO is equal to or above this field value + 1.
15:9	RO	0x0	reserved
8	RW	0x0	TDE Transmit DMA Enable 0 : Transmit DMA disabled 1 : Transmit DMA enabled
7:5	RO	0x0	reserved
4:0	RW	0x00	TDL Transmit Data Level This bit field controls the level at which a DMA request is made by the transmit logic. It is equal to the watermark level; that is, the dma_tx_req signal is generated when the number of valid data entries in the TXFIFO(TXFIFO0 if CSR=00;TXFIFO1 if CSR=01,TXFIFO2 if CSR=10,TXFIFO3 if CSR=11)is equal to or below this field value.

I2Sx_INTCR

Address: Operational Base + offset (0x0014)

interrupt control register

Bit	Attr	Reset Value	Description
31:25	RO	0x0	reserved

Bit	Attr	Reset Value	Description
24:20	RW	0x00	RFT Receive FIFO Threshold When the number of receive FIFO entries is more than or equal to this threshold plus 1, the receive FIFO full interrupt is triggered.
19	RO	0x0	reserved
18	WO	0x0	RXOIC RX overrun interrupt clear Write 1 to clear RX overrun interrupt.
17	RW	0x0	RXOIE RX overrun interrupt enable 0:disable 1:enable
16	RW	0x0	RXFIE RX full interrupt enable 0:disable 1:enable
15:9	RO	0x0	reserved
8:4	RW	0x00	TFT Transmit FIFO Threshold When the number of transmit FIFO (TXFIFO0 if CSR=00; TXFIFO1 if CSR=01, TXFIFO2 if CSR=10, TXFIFO3 if CSR=11) entries is less than or equal to this threshold, the transmit FIFO empty interrupt is triggered.
3	RO	0x0	reserved
2	WO	0x0	TXUIC TX underrun interrupt clear Write 1 to clear TX underrun interrupt.
1	RW	0x0	TXUIE TX underrun interrupt enable 0:disable 1:enable
0	RW	0x0	TXEIE TX empty interrupt enable 0:disable 1:enable

I2Sx_INTSR

Address: Operational Base + offset (0x0018)
interrupt status register

Bit	Attr	Reset Value	Description
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Bit	Attr	Reset Value	Description
31:18	RO	0x0	reserved
17	RO	0x0	RXOI RX overrun interrupt 0:inactive 1:active
16	RO	0x0	RXFI RX full interrupt 0:inactive 1:active
15:2	RO	0x0	reserved
1	RO	0x0	TXUI TX underrun interrupt 0:inactive 1:active
0	RO	0x0	TXEI TX empty interrupt 0:inactive 1:active

I2Sx_XFER

Address: Operational Base + offset (0x001c)

Transfer Start Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x0	RXS RX Transfer start bit 0:stop RX transfer. 1:start RX transfer
0	RW	0x0	TXS TX Transfer start bit 0:stop TX transfer. 1:start TX transfer

I2Sx_CLR

Address: Operational Base + offset (0x0020)

SCLK domain logic clear Register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x0	RXC RX logic clear This is a self cleared bit. Write 1 to clear all receive logic.

Bit	Attr	Reset Value	Description
0	RW	0x0	TXC TX logic clear This is a self cleared bit. Write 1 to clear all transmit logic.

I2Sx_TXDR

Address: Operational Base + offset (0x0400~0x7FC)
Transmit FIFO Data Register

Bit	Attr	Reset Value	Description
31:0	WO	0x00000000	TXDR Transmit FIFO Data Register When it is written to, data are moved into the transmit FIFO.

I2Sx_RXDR

Address: Operational Base + offset (0x0800~0xBFC)
Receive FIFO Data Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	RXDR Receive FIFO Data Register When the register is read, data in the receive FIFO is accessed.

28.5 Timing Diagram

28.5.1 Master mode

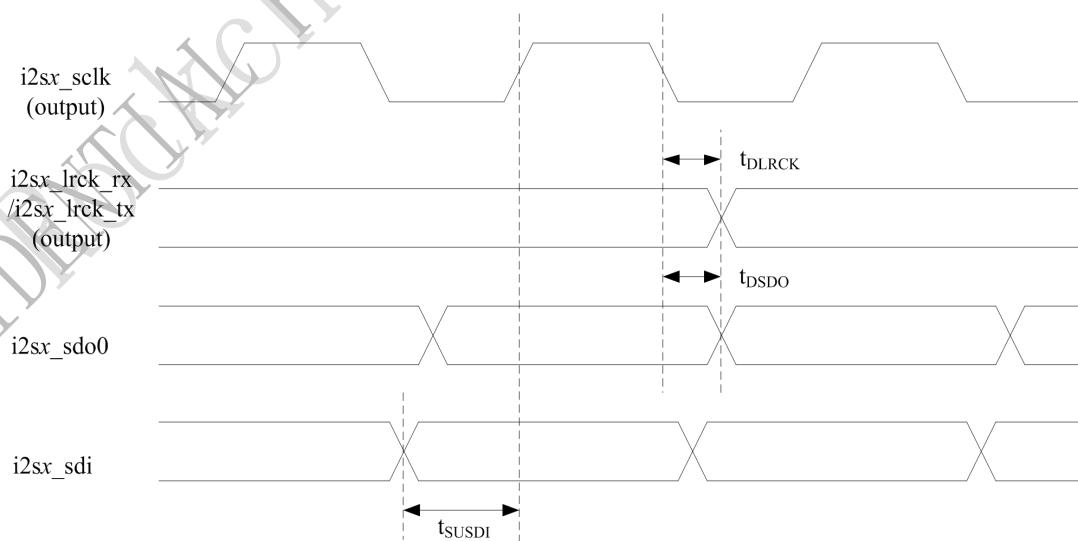


Fig. 28- 11 Master mode timing diagram
Table 28- 1 Meaning of the parameter in Fig. 29-11

Parameter	Description	min	typ	max	unit

t_{DLRCK}	i2s1_lrck_rx/i2s1_lrck_tx propagation delay from i2s1_sclk falling edge	0.049	0.203	0.744	ns
t_{DSDO}	i2s1_sdo propagation delay from i2s1_sclk falling edge	0.279	0.487	1.081	ns
t_{SUSDI}	i2s1_sdi setup time to i2s1_sclk rising edge	1.312	3.961	7.646	ns

28.5.2 Slave mode

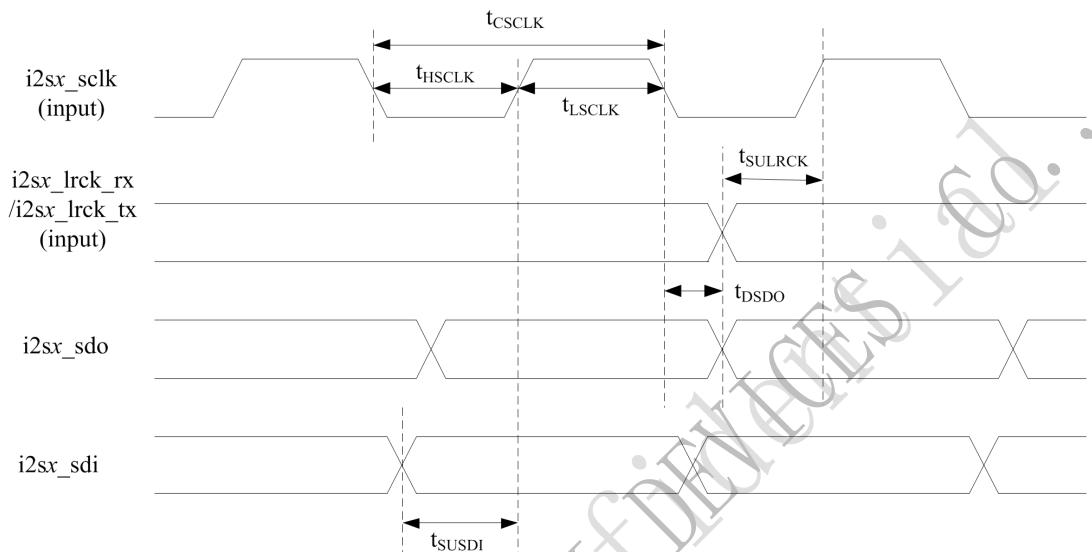


Fig. 28-12 Slave mode timing diagram
Table 28-2 Meaning of the parameter in Fig. 29-12

Parameter	Description	min	typ	max	unit
t_{CSCLK}	i2s1_sclk cycle time (cannot be less than 40ns)	-	-	-	ns
t_{HSCLK}	i2s1_sclk pulse width high (cannot be less than 20ns)	-	-	-	ns
t_{LSCLK}	i2s1_sclk pulse width low (cannot be less than 20ns)	-	-	-	ns
t_{SULRCK}	i2s1_lrck_rx/i2s1_lrck_tx setup time to i2s1_sclk falling edge	1.539	2.139	2.795	ns
t_{DSDO}	i2s1_sdo propagation delay from i2s1_sclk falling edge	5.006	7.185	10.63	ns
t_{SUSDI}	i2s1_sdi setup time to i2s1_sclk rising edge	1.590	2.226	2.957	ns

28.6 Interface description

Module Pin	Direction	Pad Name	IOMUX Setting
I2S			
i2s_clk	O	GPIO1_C[0]	GRF_GPIO1C_IOMUX[0]=1'b1
i2s_sclk	I/O	GPIO1_C[1]	GRF_GPIO1C_IOMUX[2]=1'b1
i2s_lrck_rx	I/O	GPIO1_C[2]	GRF_GPIO1C_IOMUX[4]=1'b1
i2s_lrck_tx	I/O	GPIO1_C[3]	GRF_GPIO1C_IOMUX[6]=1'b1
i2s_sdi	I	GPIO1_C[4]	GRF_GPIO1C_IOMUX[8]=1'b1
i2s_sdo	O	GPIO1_C[5]	GRF_GPIO1C_IOMUX[10]=1'b1

28.7 Application Notes

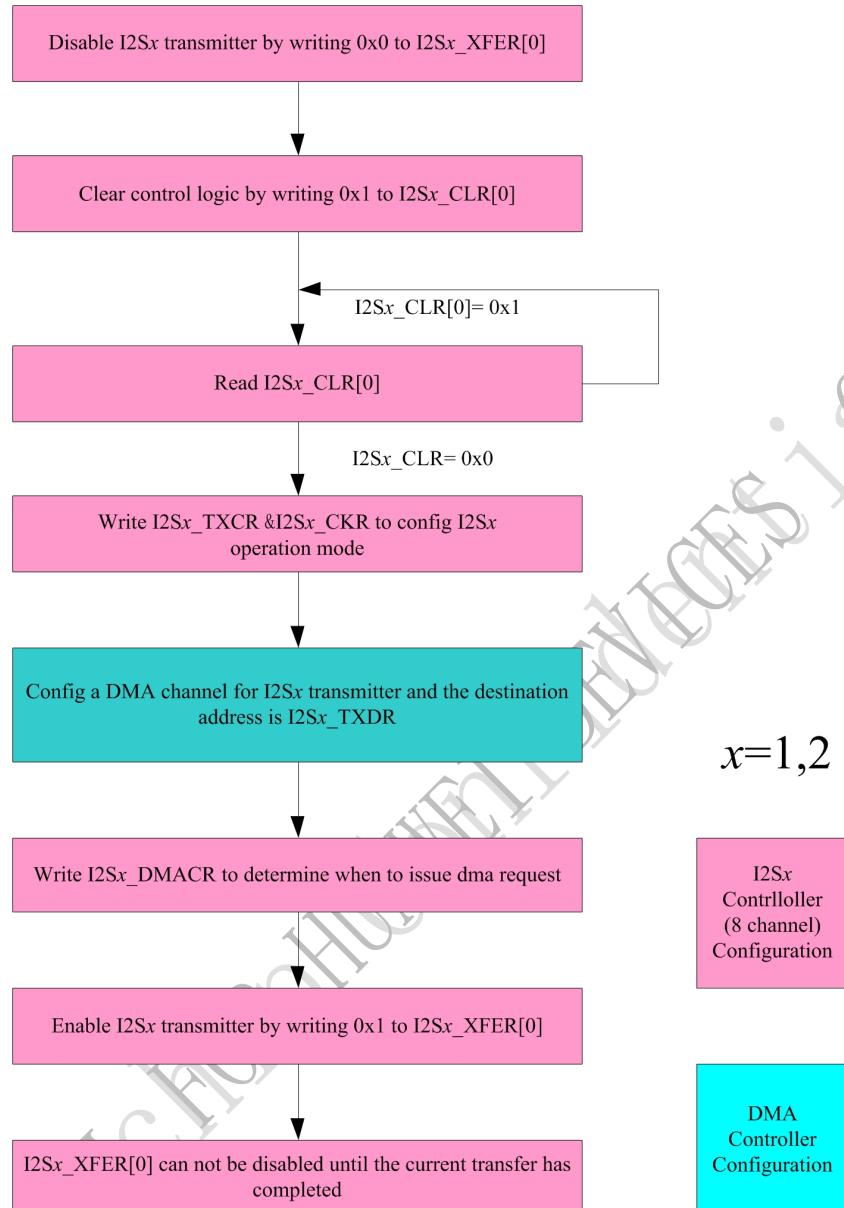


Fig. 28- 13I2S/PCM1/2 controller transmit operation flow chart

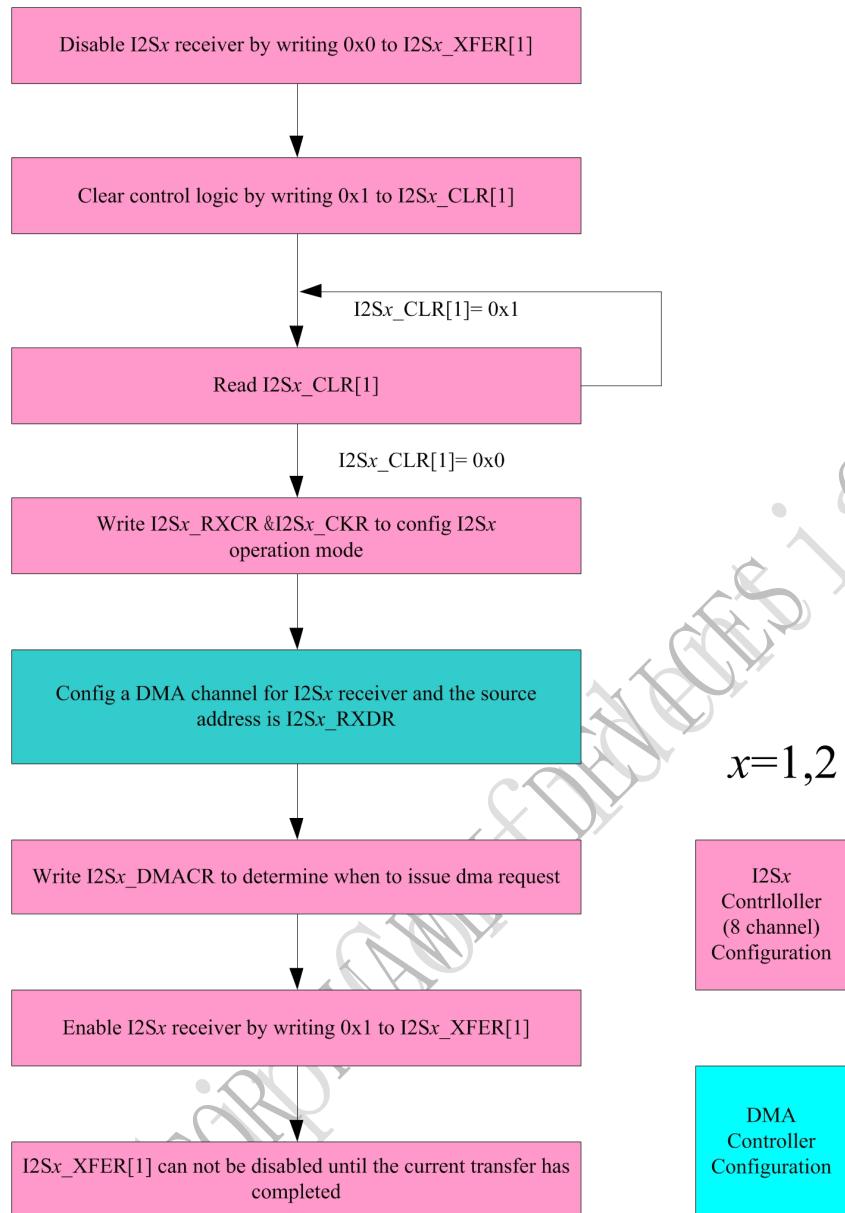


Fig. 28- 14I2S/PCM1/2 controller receive operation flow chart

Chapter 29 SPDIF transmitter

29.1 Overview

The SPDIF transmitter is a self-clocking, serial, un-directional interface for the interconnection of digital audio equipment for consumer and professional applications, using linear PCM coded audio samples.

It provides the basic structure of the interface. Separate documents define items specific to particular applications.

When used in a professional application, the interface is primarily intended to carry monophonic or stereophonic programmes, at a 48 kHz sampling frequency and with a resolution of up to 24 bits per sample; it may alternatively be used to carry signals sampled at 32 kHz or 44.1 kHz.

When used in a consumer application, the interface is primarily intended to carry stereophonic programmes, with a resolution of up to 20 bits per sample, an extension to 24 bits per sample being possible.

When used for other purposes, the interface is primarily intended to carry audio data coded other than as linear PCM coded audio samples. Provision is also made to allow the interface to carry data related to computer software or signals coded using non-linear PCM. The format specification for these applications is not part of this standard.

In all cases, the clock references and auxiliary information are transmitted along with the programme.

- Support one internal 32-bit wide and 32-location deep sample data buffer
- Support two 16-bit audio data store together in one 32-bit wide location
- Support AHB bus interface
- Support biphase format stereo audio data output
- Support DMA handshake interface and configurable DMA water level
- Support sample data buffer empty and block terminate interrupt
- Support combine interrupt output
- Support 16 to 31 bit audio data left or right justified in 32-bit wide sample data buffer
- Support 48, 44.1, 32kHz sample rate
- Support 16, 20, 24 bits audio data transfer

29.2 Block Diagram

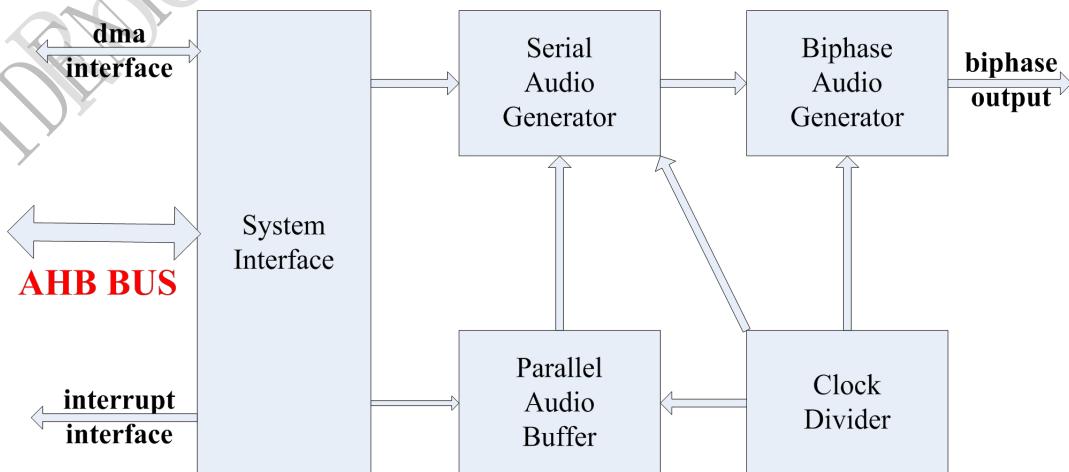


Fig. 29-1SPDIF transmitter Block Diagram

System Interface

The system interface implements the AHB slave operation. It contains not only control registers of transmitters and receiver inside but also interrupt and DMA handshake interface.

Clock Divider

The Clock Divider implements clock generation function. The input source clock to the module is MCLK, and by the divider of the module, the clock divider generates work clock for digital audio data transformation.

Parallel Audio Buffer

The Parallel Audio Buffer is the buffer to store transmitted audio data. The size of the FIFO is 32bits x 32.

Serial Audio Converter

The Serial Audio Converter reads parallel audio data from the Parallel Audio Buffer and converts it to serial audio data.

Biphase Audio Generator

The Biphase Audio Generator reads serial audio data from the Serial Audio Converter and generates biphase audio data based on IEC-60958 standard.

29.3 Function description

29.3.1 Frame Format

A frame is uniquely composed of two sub-frames. For linear coded audio applications, the rate of transmission of frames corresponds exactly to the source sampling frequency.

In the 2-channel operation mode, the samples taken from both channels are transmitted by time multiplexing in consecutive sub-frames. The first sub-frame(left channel in stereophonic operation and primary channel in monophonic operation) normally use preamble M. However, the preamble is changed to preamble B once every 192 frame to identify the start of the block structure used to organize the channel status information. The second sub-frame (right in stereophonic operation and secondary channel in monophonic operation) always use preamble W.

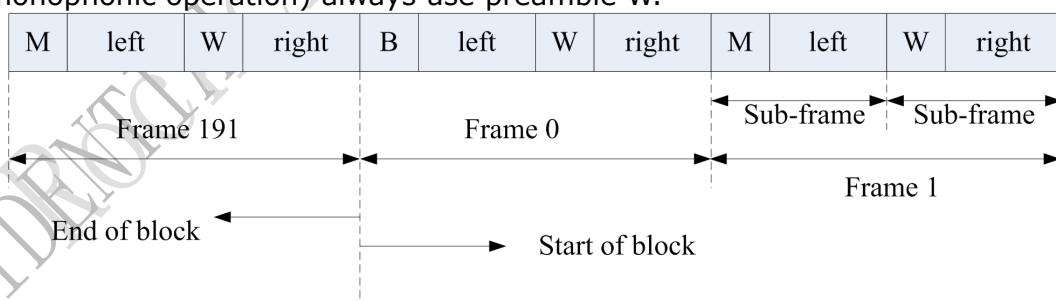


Fig. 29- 2SPDIF Frame Format

In the single channel operation mode in a professional application, the frame format is the same as in the 2-channel mode. Data is carried only in the first sub-frame and may be duplicated in the second sub-frame. If the second sub-frame is not carrying duplicate data, then time slot 28 (validity flag) shall be set to logical '1' (not valid).

29.3.2 Sub-frame Format

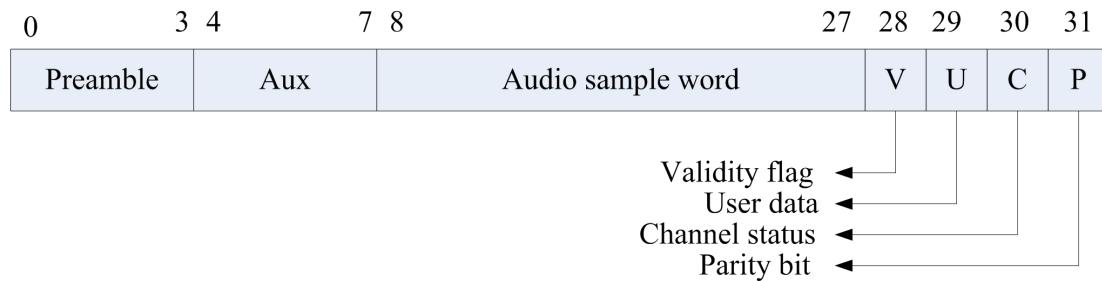


Fig. 29- 3SPDIF Sub-frame Format

Each sub-frame is divided into 32 time slot, numbered from 0 to 31. Time slot 0 to 3 carries one of the three permitted preambles. Time slots 4 to 27 carry the audio sample word in linear 2's complement representation. The MSB is carried by time slot 27. When a 24-bit coding range is used, the LSB is in time slot 4. When a 20-bit coding range is used, time slot 8 to 27 carry the audio sample word with the LSB in time slot 8. Time slot 4 to 7 may be used for other application. Under these circumstances, the bits in the time slot 4 to 7 are designated auxiliary sample bits.

If the source provides fewer bits than the interface allows (either 24 or 20), the unused LSBs are set to a logical '0'. For a non-linear PCM audio application or a data application the main data field may carry any other information. Time slot 28 carries the validity flag associated with the main data field. Time slot 29 carries 1 bit of the user data associated with the audio channel transmitted in the same sub-frame. Time slot 30 carries one bit of the channel status words associated with the main data field channel transmitted in the same sub-frame. Time slot 31 carries a parity bit such that time slots 4 to 31 inclusive carries an even number of ones and an even number of zeros.

29.3.3 Channel Coding

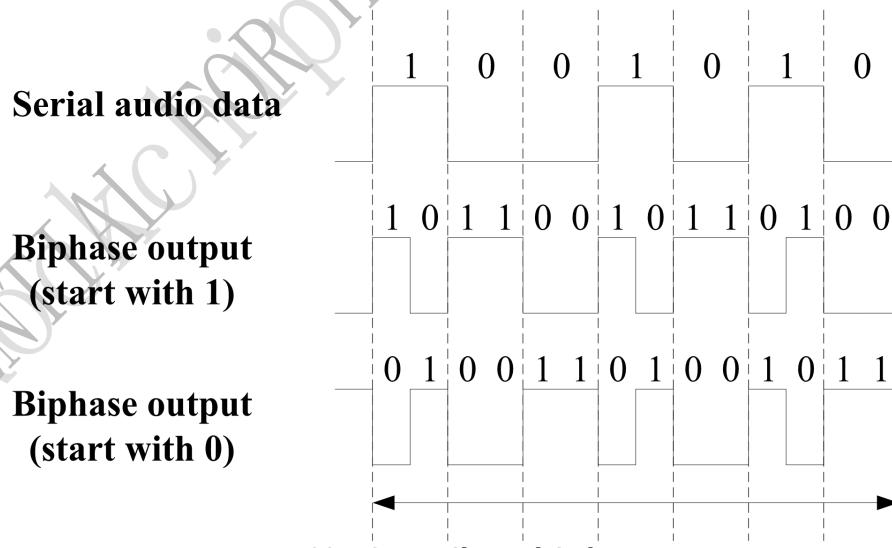


Fig. 29- 4SPDIF Channel Coding

To minimize the direct current component on the transmission line, to facilitate clock recovery from the data stream and to make the interface insensitive to the polarity of connections, time slots 4 to 31 are encoded in biphasic-mark.

Each bit to be transmitted is represented by a symbol comprising two consecutive binary states. The first state of a symbol is always different from the

second state of the previous symbol. The second state of the symbol is identical to the first if the bit to be transmitted is logical '0'. However, it is different from the first if the bit is logical '1'

29.3.4 Preamble

Preambles are specific patterns providing synchronization and identification of the sub-frames and blocks.

To achieve synchronization within one sampling period and to make this process completely reliable, these patterns violate the biphase-mark code rules, thereby avoiding the possibility of data imitating the preambles.

A set of three preambles is used. These preambles are transmitted in the time allocated to four time slots (time slots 0 to 3) and are represented by eight successive states. The first state of the preamble is always different from the second state of the previous symbol.

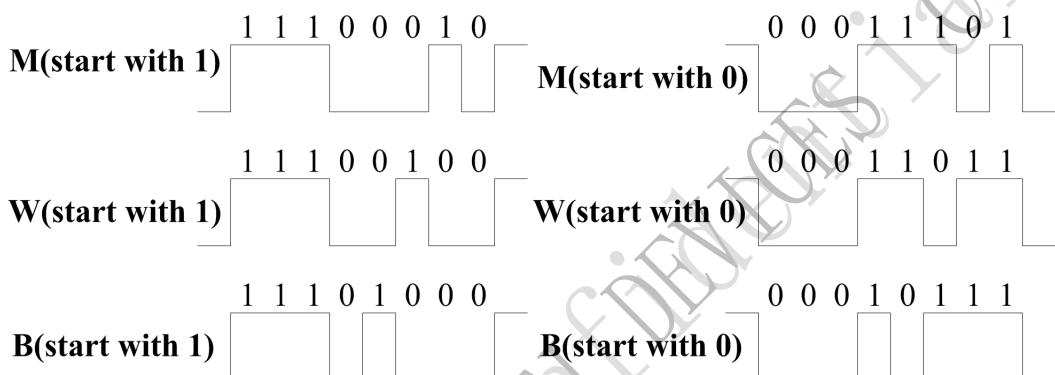


Fig. 29-5SPDIF Preamble

Like biphase code, these preambles are dc free and provide clock recovery. They differ in at least two states from any valid biphase sequence.

29.4 Register description

29.4.1 Register Summary

Name	Offset	Size	Reset value	Description
SPDIF_CFGR	0x00	W	0x0	Transfer Configuration Register
SPDIF_SDBLR	0x04	W	0x0	Sample Date Buffer Level Register
SPDIF_DMCR	0x08	W	0x0	DMA Control Register
SPDIF_INTCR	0x0C	W	0x0	Interrupt Control Register
SPDIF_INTSR	0x10	W	0x0	Interrupt Status Register
SPDIF_XFER	0x18	W	0x0	Transfer Start Register
SPDIF_SMPDR	0x20	W	0x0	Sample Data Register
SPDIF_VLDFR	0x60~0x8C	W	0x0	Validity Flag Register
SPDIF_USRDR	0x90~0xBC	W	0x0	User Data Register
SPDIF_CHNSR	0xC0~0xEC	W	0x0	Channel Status Register

Notes:

Size: B – Byte (8 bits) access, HW – Half WORD (16 bits) access, W – WORD (32 bits) access

29.4.2 Detail Register Description

SPDIF_CFGR

Address: operational base+offset(0x00)

Transfer Configuration Register

Bit	Attr	Reset Value	Description
31:24	-	-	Reserved.
23:16	RW	0x0	Fmclk/Fsdo This parameter can be caculated by Fmclk/(Fs*128). Fs=the sample frequency be wanted
15:8	-	-	Reserved.
7	W	0x0	Write 1 to clear mclk domain logic. Read return zero.
6	RW	0x0	Channel status enable
5	RW	0x0	User data enable
4	RW	0x0	Validity flag enable
3	RW	0x0	Apb valid audio data justified 0:Right justified 1:Left justified
2	RW	0x0	Halfword word transform enable 0:disable 1:enable
1:0	RW	0x0	Valid data width 00: 16bit 01: 20bit 10: 24bit 11: reserved

SPDIF_SDBLR

Address: operational base+offset(0x04)

Sample Date Buffer Level Register

Bit	Attr	Reset Value	Description
31:6	-	-	Reserved.
5:0	R	0x0	Sample Date Buffer Level Register. Contains the number of valid data entries in the sample data buffer.

SPDIF_DMACR

Address: operational base+offset(0x08)

DMA Control Register

Bit	Attr	Reset Value	Description
31:6	-	-	Reserved.
5	RW	0x0	Transmit DMA Enable. 0 = Transmit DMA disabled 1 = Transmit DMA enabled
4:0	RW	0x0	Transmit Data Level. This bit field controls the level at which a DMA request is made by the transmit logic. It is equal to the watermark level; that is, the dma_tx_req signal is generated when the number of valid data entries in the Sample Date Buffer is equal to or below this field value

SPDIF_INTCR

Address:operational base+offset(0x0C)

Interrupt Control Register

Bit	Attr	Reset Value	Description
31: 17	-	-	Reserved.
16	W	0x0	Block transfer terminate interrupt clear
15: 10	-	-	Reserved.
9:5	RW	0x0	Sample Date Buffer Threshold for empty interrupt
4	RW	0x0	Sample Date Buffer empty interrupt enable. 0:disable; 1: enable;
3	RW	0x0	Block transfer terminate interrupt enable. 0:disable; 1: enable;
2:0	-	-	Reserved.

SPDIF_INTSR

Address:operational base+offset(0x10)

Interrupt Status Register

Bit	Attr	Reset Value	Description
31: 5	-	-	Reserved.
4	R	0x0	Sample Date Buffer empty interrupt status. 0:inactive; 1: active;
3	R	0x0	Block transfer terminate interrupt status. 0:inactive; 1: active;
2:0	-	-	Reserved.

SPDIF_XFER

Address:operational base+offset(0x18)

Transfer Start Register

Bit	Attr	Reset Value	Description
31: 1	-	-	Reserved.
0	RW	0x0	Transfer Start Register.

SPDIF_SMPDR

Address:operational base+offset(0x20)

Sample Data Register

Bit	Attr	Reset Value	Description
31:0	W	0x0	Sample Data Register.

SPDIF_VLDFR

Address:operational base+offset(0x60~0x8C)

Validity Flag Register

Bit	Attr	Reset Value	Description
31:0	RW	0x0	Validity Flag Register.

SPDIF_USRDR

Address:operational base+offset(0x90~0xBC)

User Data Register

Bit	Attr	Reset Value	Description
31:0	RW	0x0	User Data Register.

SPDIF_CHNSR

Address:operational base+offset(0xC0~0xEC)

Channel Status Register.

Bit	Attr	Reset Value	Description
31:0	RW	0x0	Channel Status Register.

29.5 Interface description

Module Pin	Direction	Pad Name	IOMUX Setting
spdif_tx	O	GPIO1_B[2]	GRF_GPIO1B_IOMUX[4]=1

29.6 Application Notes

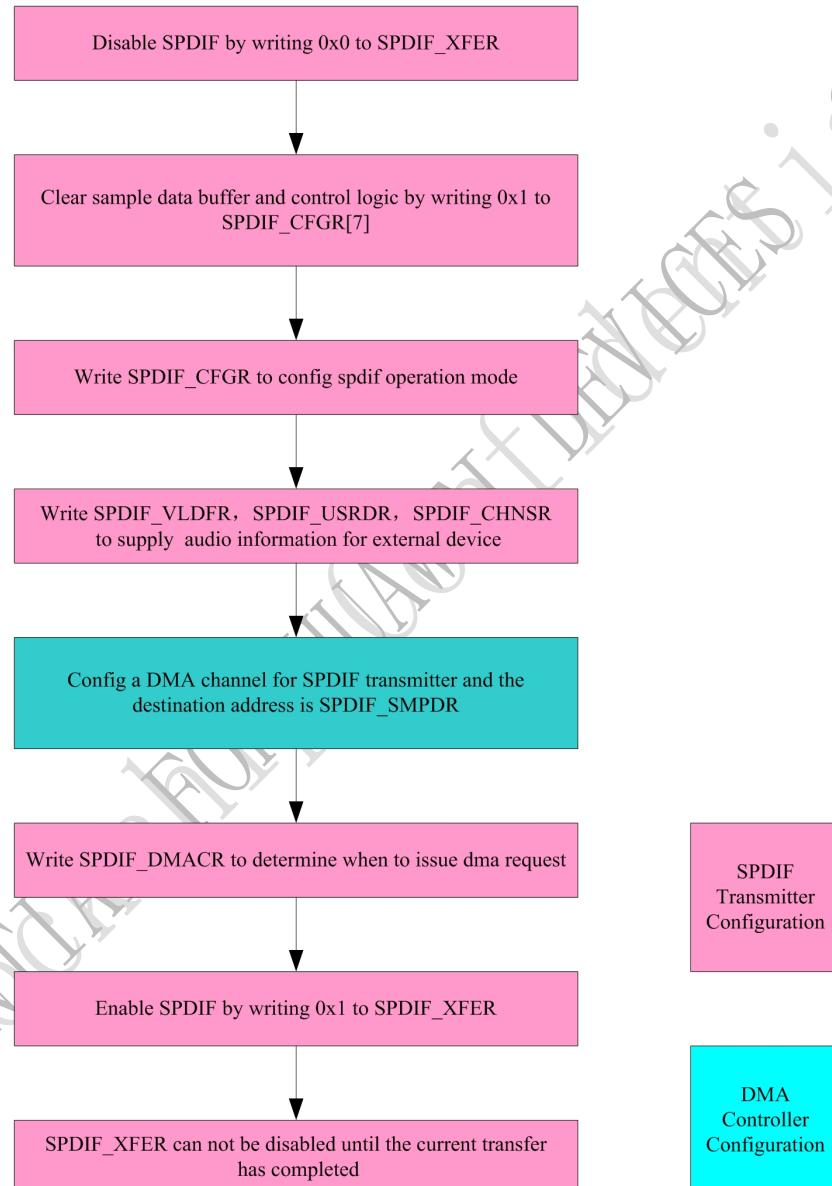


Fig. 29- 6 SPDIF transmitter operation flow chart

Chapter 30 SDIO Host Controller

30.1 Overview

The SDMMC Host Controller is designed to support Secure Digital memory (SD mem - version 3.00), Secure Digital I/O(SDIO-version 3.00), Multimedia Cards(MMC-version 4.41).The SDMMC support SD Card(1/4bit), SDIO, MMC(1/4bit).

Feature

- Supports AMBA AHB interface
- Supports DMA controller for data transfers
- Supports interrupt output
- Supports SD version3.0 except SPI mode
- Supports MMC version4.41 except SPI mode
- Supports SDIO version3.0
- Supports programmable baud rate.
- Provides individual clock control to selectively turn ON or OFF clock to a card
- Supports power management and power switch. Provides individual power control to selectively turn ON or OFF power to a card
- Support DDR in 4-bit mode

30.2 Block Diagram

The SD/MMC controller consists of the following main functional blocks, which are illustrated in Fig. 17-1.

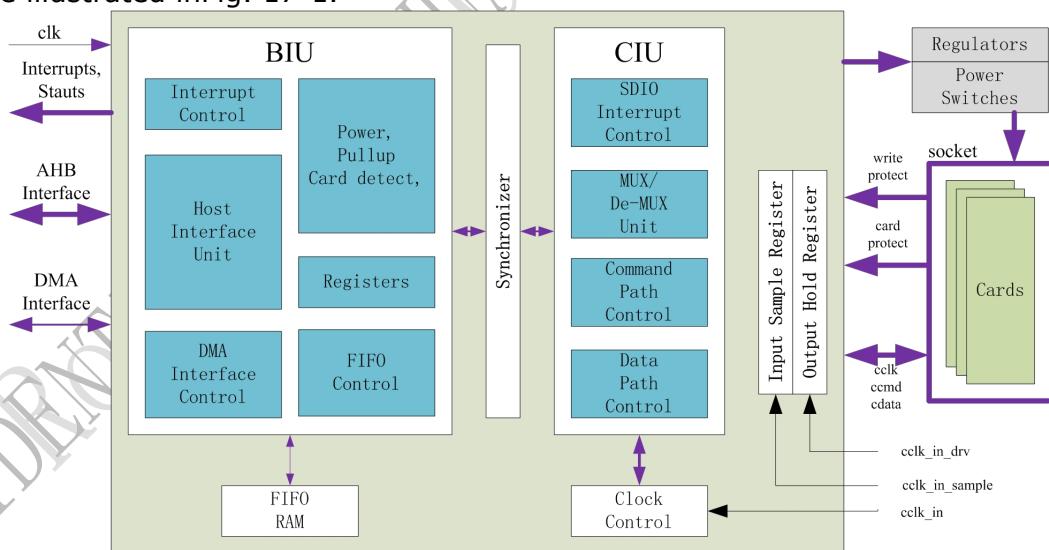


Fig. 30-1 SD/MMC Controller Block Diagram

- Bus Interface Unit (BIU) – Provides AMBA AHB and DMA interfaces for register and dataread/writes.
- Card Interface Unit (CIU) – Takes care of the SD_MMC protocols and provides clockmanagement.

30.3 Function description

Ref 17.3

30.4 Register description

Ref 17.4

30.5 Timing Diagram

30.6 Interface description

30.6.1 Card-Detect and Write-Protect Mechanism

Figure 17-6 illustrates how the SD/MMC Host Controller card detection and write-protect signals are connected. Most of the SD_MMC sockets have card-detect pins. When no card is present, card_detect_n is 1 due to the pull-up. When the SD_MMC card is inserted, the card-detect pin is shorted to ground, which makes card_detect_n go to 0. Similarly in SD cards, when the write-protect switch is toward the left, it shorts the write_protect port to ground.

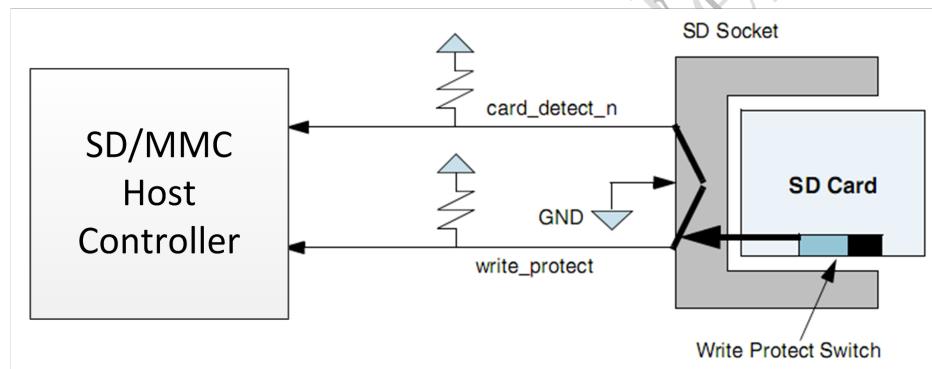


Fig. 30-2 Card-Detect and Write-Protect

30.6.2 SD/MMC Controller Termination Requirement

Fig.17-7 illustrates the SD/MMC Host Controller termination requirements, which is required to pull up ccmd and cdata lines on the SD_MMC bus. The recommended specification for pull-up on the ccmd line (Rcmd) is 4.7K - 100K for MMC, and 10K - 100K for an SD. The recommended pull-up on the cdata line (Rdat) is 50K - 100K.

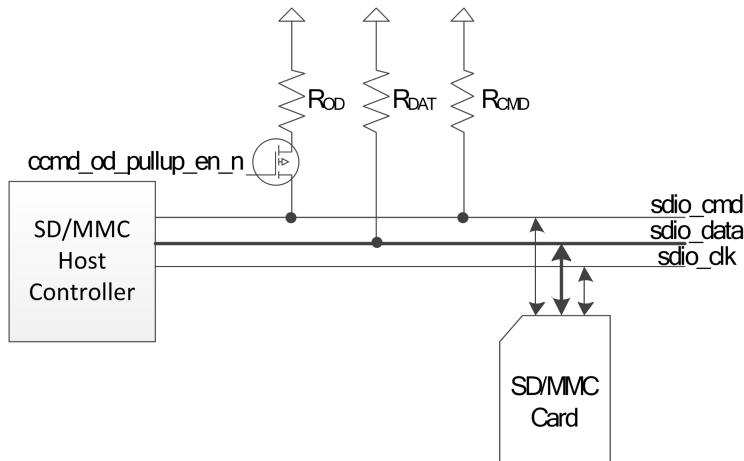


Fig. 30-3 SD/MMC Termination

Rcmd and Rod Calculation

The SD and MMC card enumeration happens at a very low frequency – 100-400KHz. Since the MMC bus is a shared bus between multiple cards, during enumeration open-drive mode is used to avoid bus conflict. Cards that drive 0 win over cards that drive “z.” The pull-up in the command line pulls the bus to 1 when all cards drive “z.” MMC interrupt mode also uses the pull-up. During normal data transfer, the host chooses only one card and the card driver switches to push-pull mode.

For example, if enumeration is done at 400KHz and the total bus capacitance is 200 pf, the pull-up needed during enumeration is:

$$\begin{aligned}
 2.2 \text{ RC} &= \text{rise-time} = 1/400\text{KHz} \\
 R &= 1/(2.2 * C * 100\text{KHz}) \\
 &= 1/(2.2 * 200 * 10^{**-12} * 400 * 10^{**3}) \\
 &= 1/(17.6 * 10^{**-5}) \\
 &= 5.68\text{K}
 \end{aligned}$$

The Rod and Rcmd should be adjusted in such a way that the effective pull-up is at the maximum 5.68K during enumeration. If there are only a few cards in the bus, a fixed Rcmd resistor is sufficient and there is no need for an additional Rod pull-up during enumeration. You should also ensure the effective pull-up will not violate the I_{OL} rating of the drivers.

In SD mode, since each card has a separate bus, the capacitance is less, typically in the order of 20-30pf (host capacitance + card capacitance + trace + socket capacitance). For example, if enumeration is done at 400KHz and the total bus capacitance is 20pf, the pull-up needed during enumeration is:

$$\begin{aligned}
 2.2 \text{ RC} &= \text{rise-time} = 1/400\text{KHz} \\
 R &= 1/(2.2 * C * 100\text{KHz}) \\
 &= 1/(2.2 * 20 * 10^{**-12} * 400 * 10^{**3}) \\
 &= 1/(1.76 * 10^{**-5}) \\
 &= 56.8\text{K}
 \end{aligned}$$

Therefore, a fixed 56.8K permanent Rcmd is sufficient in SD mode to enumerate the cards.

The driver of the SD/MMC Host Controller on the “command” port needs to be only a push-pull driver. During enumeration, the SD/MMC Host Controller emulates an open-drain driver by driving only a 0 or a “z” by controlling the ccmd_out and ccmd_out_en signals.

30.6.3 SD/MMC Controller IOMUX

The SDMMC Host Controller share the pin with GPIO. In default, the pins are used for GPIO, if user want to work in sdmmc function, the user must configure the GRF registers as following table:

Table 30-1 SDMMC IOMUX Settings

Module Pin	Direction	Pad Name	IOMUX Setting
sdio_clkout	O	GPIO3_C[5]	GPIO3C_IOMUX[11:10]=0x01
sdio_cmd	I/O	GPIO3_C[0]	GPIO3C_IOMUX[1:0]=0x01
sdio_data0	I/O	GPIO3_C[1]	GPIO3C_IOMUX[3:2]=0x01
sdio_data1	I/O	GPIO3_C[2]	GPIO3C_IOMUX[5:4]=0x01
sdio_data2	I/O	GPIO3_C[3]	GPIO3C_IOMUX[7:6]=0x01
sdio_data3	I/O	GPIO3_C[4]	GPIO3C_IOMUX[7:8]=0x01
sdio_int_n	I	GPIO3_D[2]	GPIO3D_IOMUX[5:4]=0x01
sdio_detect_n	I	GPIO3_C[6]	GPIO3C_IOMUX[13:12]=0x01
sdio_write_prt	I	GPIO3_C[7]	GPIO3C_IOMUX[15:14]=0x01
sdio_backend	O	GPIO3_D[1]	GPIO3D_IOMUX[3:2]=0x01
sdio_pwr_en	O	GPIO3_D[0]	GPIO3D_IOMUX[1:0]=0x01

Notes: Direction: **I**- Input, **O**- Output, **I/O**- Input/Output

30.7 Application Notes

Ref to 17.7

Chapter 31 MAC Ethernet Interface

31.1 Overview

The VMAC Ethernet Controller provides a complete Ethernet interface from processor to a Reduced Media Independent Interface(RMII) compliant Ethernet PHY.

The VMAC includes a DMAC controller. The DMAC controller efficiently moves packet data from microprocessor's RAM, format the data for an IEEE 802.3 compliant packet and transmit the data to an Ethernet Physical Interface(PHY). It also efficiently moves packet data from RXFIFO to microprocessor's RAM.

31.1.1 Features

- IEEE 802.3u compliant Ethernet Media Access Controller
- 10Mbps and 100Mbps compatible
- Automatic retry and automatic collision frame deletion
- Reduced Media Independent Interface (RMII) for PHY connection
- Management Interface (MDIO) state machine for easy real-time communication with the PHY.
- Full Duplex Support
- Pause full-duplex flow-control support
- Address filtering -Broadcast/Multicast/Logic/Physical
- Complete DMA buffer management controller for minimal processor overhead
- Wake-On-LAN low-power mode support
- AHB interface to any CPU or memory

31.2 Block Diagram

31.2.1 Architecture

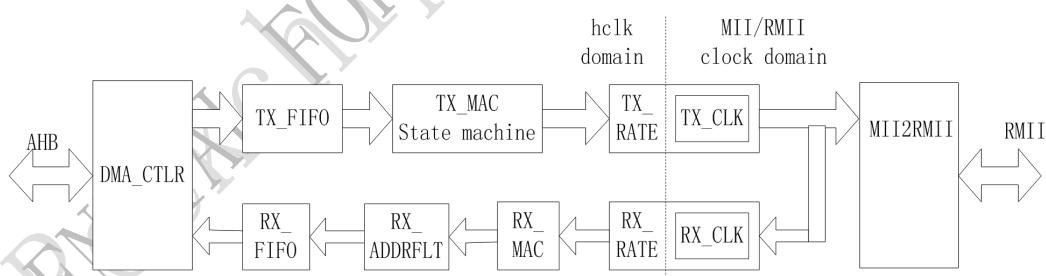


Fig. 31-1 VMAC architecture

The VMAC is broken up into nine separate functional units. These nine blocks are interconnected in the VMAC module. The block diagram shows the general flow of data and control signals between these blocks.

The DMA_CTLR controller moves data between system memory and the respective TX or RX pipelines and manages the buffer descriptors. A single state machine handles the Buffer Descriptors as well as both the RX and TX DMAs. Transmit and Receive DMAs may be interleaved as well as polling of the buffer descriptor rings. The DMA controller also includes all of the configuration, control and status registers of the VMAC as well as the MDIO state machine for communicating to the PHY.

The transmit FIFO and its controller are integrated in the TX_FIFO block. The FIFO is typically built of a 512x8bit dual-port RAM.

The TX_MAC provides all of the logic necessary to build and transmit a frame that meets the IEEE 802.3 Ethernet LAN standard. When a start of frame is detected on the data/status bus, then the TX_MAC block starts to transmit preamble data. TX_MAC delays the transmission if the receive path is active in Half-Duplex mode and ensures that the interframe period is met. In Full-Duplex mode only the interframe period is observed and no deferring process takes place.

The TX_RATE block transfers the raw packet data from the HCLK to the CLK_TX clock domains. In addition to its main function, the TX_RATE block monitors the collision signal COL from the PHY and the preamble field from TX_RATE. In case of a collision, the TX_RATE jams the data on TXD bus and notifies TX_MAC about the collision.

The RX_FIFO block is composed with a 1024x9 bit dual-port ram.

The RX_ADDRFLT block determines if the destination address matches under any of the currently-active addressing modes. While the Destination Address field is being verified, the incoming bytes are stored in a small FIFO. If the Destination address does not match, then the RX_ADDRFLT resets its FIFO and disregards incoming data.

The RX_MAC block provides all of the logic necessary to meet the IEEE 802.3 Ethernet LAN standard for frame reception. The RX_MAC detects the SFD pattern, verifies FCS field, senses framing errors (odd number of nibbles) and monitors the RX_ER signal, which indicates any other errors received from an external PHY.

The RX_RATE block synchronizes signals from MII CLK_RX domain to hclk domain.

The MII2RMII block transfers MII signals to RMII signals.

31.2.2 Frame Structure

Data frames transmitted shall have the frame format shown in Fig 32-2.

<inter-frame><preamble><sfd><data><efd>

Fig. 31- 2 VMAC Frame structure

The preamble <preamble> begins a frame transmission. The bit value of the preamble field consist of 7 octets with the folling bit values:

10101010 10101010 10101010 10101010 10101010 10101010 10101010

The SFD (start frame delimiter) <sfd> indicates the start of a frame and follows the preamble. The bit value is 10101011.

The data in a well formed frame shall consist of N octets data.

31.2.3 RMII Interface timing diagram

1. Transmission diagram

Fig. 32-3 shows the 100Mb/s Transmission diagram. The REF_CLK frequency is 50MHz in RMII interface.

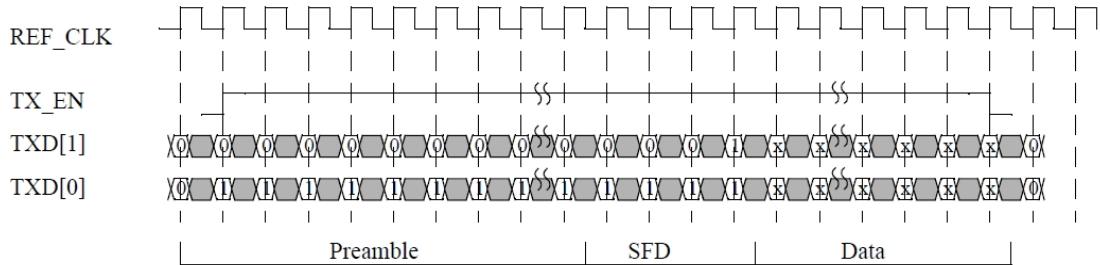


Fig. 31- 3RMII transmission in 100Mb/s mode

In 10Mb/s mode, as the REF_CLK frequency is 10 times as the data rate, the value on TXD[1:0] shall be valid such that TXD[1:0] may be sampled every 10th cycle, regard-less of the starting cycle within the gRup and yield the correct frame data.

2. Reception diagram

Fig.32-4 shows the 100Mb/s reception diagram. The REF_CLK frequency is 50MHz in RMII interface.

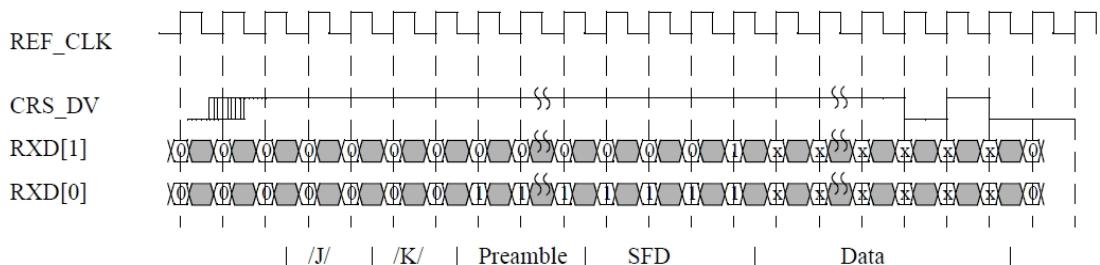


Fig. 31- 4 RMII reception with no errors in 100Mb/s mode

In 10Mb/s mode, as the REF_CLK frequency is 10 times the data rate, the value on RXD[1:0] shall be valid such that RXD[1:0] may be sampled every 10th cycle, regardless of the starting cycle within the gRup and yield the correct frame data.

31.2.4 Management Interface

The MII management interface provides a simple, tW-wire, serial interface to connect the VMAC and a managed PHY, for the purposes of controlling the PHY and gathering status from the PHY. The management interface consists of a pair of signals that transport the management information across the MII bus: MDIO and MDC.

31.3 Register description

31.3.1 Register Summary

Name	Offset	Size	Reset Value	Description
EMAC_ID	0x0000	W	0x00053d02	hardware version
EMAC_STAT	0x0004	W	0x00000000	Interrupt status register
EMAC_ENABLE	0x0008	W	0x00000000	Interrupt enable register
EMAC_CONTROL	0x000c	W	0x00000000	CONTROL Register

Name	Offset	Size	Reset Value	Description
EMAC_POLLRATE	0x0010	W	0x00000000	Poll Rate register
EMAC_RXERR	0x0014	W	0x00000000	Receive Error Counters
EMAC_MISS	0x0018	W	0x00000000	Missed Packet Counter
EMAC_TXRINGPTR	0x001c	W	0x00000000	Transmit Ring Pointer address register
EMAC_RXRINGPTR	0x0020	W	0x00000000	Receive Ring Pointer address register
EMAC_ADDR	0x0024	W	0x00000000	Ethernet MAC Address , low 32 bits
EMAC_ADDRH	0x0028	W	0x00000000	Ethernet MAC Address, high 16 bits
EMAC_LAFL	0x002c	W	0x00000000	Logical Address filter Register Low
EMAC_LAFH	0x0030	W	0x00000000	Logical Address filter Register High
EMAC_MDIO_DATA	0x0034	W	0x00000000	MDIO access register
EMAC_TXRINGPTR_READ	0x0038	W	0x00000000	Transmit Ring Pointer read-back register
EMAC_RXRINGPTR_READ	0x003c	W	0x00000000	Receive Ring Pointer read-back register

Notes:Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

31.3.2 Detail Register Description

EMAC_ID

Address: Operational Base + offset (0x0000)
hardware version

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved
23:16	RO	0x05	Revision Revision number Revision number (currently Rev 5)
15:14	RO	0x0	reserved
13:8	RO	0x3d	NOTID Ones-Complement of the ID Ones-Complement of the ID, (111101b)
7:6	RO	0x0	reserved
5:0	RO	0x02	ID Identificaiton number Identificaiton number, always 2 for VMAC

EMAC_STAT

Address: Operational Base + offset (0x0004)

Interrupt status register

Bit	Attr	Reset Value	Description
31	RW	0x0	TXPL TXPOLL Writing a one forces a poll of the transmit descriptors. Always write this bit with a one after adding a packet to the transmit BDT. Always read as zero.
30:13	RO	0x0	reserved
12	RW	0x0	MDIO MDIO Complete The register access to the PHY has completed
11	RO	0x0	reserved
10	RW	0x0	RXFL RX OVER FLOW The RXOFLOWERR counter has rolled over
9	RW	0x0	RXFR RXFRAME The RXFRAMEERR counter has rolled over
8	RW	0x0	RXCR RXCRC The RXCRCERR counter has rolled over
7:5	RO	0x0	reserved
4	RW	0x0	MSER MISSERR Missed packet counter has rolled over
3	RW	0x0	TXCH TX Chaining Error A bad combination of FIRST and LAST bits has been encountered. The VMAC asserts this error bit and disables the TXRN bit in the CONTROL register.
2	RO	0x0	ERR Error interrupt pending Error interrupt pending . is the logical OR of all of the other error bits in the status register (all interrupts except TXINT , RXINT and MDIO). This is a read-only bit

Bit	Attr	Reset Value	Description
1	RW	0x0	<p>RXINT Receive Interrupt Pending RXINT is set when the VMAC clears the OWN bit of an RX BDT and LAST=1. Note that multiple RX BDTs could be cleared before the RXINT interrupt is serviced. Thus ALL RX BDTs must be processed within the interrupt. This also results in the possibility that there will be a RXINT without any corresponding BDTs with their OWN bits cleared. This is normal and the software driver must handle this case.</p>
0	RW	0x0	<p>TXINT Transmit Interrupt Pending TXINT is set when the OWN bit of a TX BDT is cleared to 0 by the VMAC and LAST=1. Note that multiple TX BDTs could be cleared before the TXINT interrupt is serviced. Thus ALL TX BDTs must be processed within the interrupt. This also results in the possibility that there will be a TXINT without any corresponding BDTs with their OWN bits cleared. This is normal and the software driver must handle this case.</p>

EMAC_ENABLE

Address: Operational Base + offset (0x0008)

Interrupt enable register

Bit	Attr	Reset Value	Description
31	RW	0x0	<p>TXPL TXPOLL TXPOLL</p>
30:13	RO	0x0	reserved
12	RW	0x0	<p>MDIO MDIO Complete enable MDIO Complete enable</p>
11	RO	0x0	reserved
10	RW	0x0	<p>RXFL RXOFLOWERR counter rolled over error enable Field0000 Description</p>
9	RW	0x0	<p>RXFR RXFRAAMEERR counter rolled over error enable RXFRAAMEERR counter rolled over error enable</p>

Bit	Attr	Reset Value	Description
8	RW	0x0	RXCR RXFRAMEERR counter rolled over error enable RXFRAMEERR counter rolled over error enable
7:5	RO	0x0	reserved
4	RW	0x0	MSER Missed packet counter error enable Missed packet counter error enable
3	RW	0x0	TXCH TX Chaining Error enable TX Chaining Error enable
2	RW	0x0	ERR Error Interrupt Pending Enable Error Interrupt Pending Enable
1	RW	0x0	RXINT Receive interrupt pending enable Receive interrupt pending enable
0	RW	0x0	TXINT Transmit interrupt pending enable Transmit interrupt pending enable

EMAC_CONTROL

Address: Operational Base + offset (0x000c)

CONTROL Register

Bit	Attr	Reset Value	Description
31:24	RW	0x00	RXBDTLEN RXBDTLEN Number of BDTs in the RX Ring. 1-255 allowed.
23:16	RW	0x00	TXBDTLEN TXBDTLEN Number of BDTs in the TX Ring. 1-255 allowed.
15	RW	0x0	DISAD DISADDRC 1: disable adding the 4byte CRC(FCS) on every packet. Instead, use the ADDCRC bit in the INFO word of the Transmit Buffer descriptor to add the FCS on a packet by packet basis. 0: always add CRC and ignore the ADDCRC bit in the info field

Bit	Attr	Reset Value	Description
14	RW	0x0	DISRT DISRETRY 1: disable retries, tx will be attempted only once.
13	RW	0x0	TEST TEST used for silicon testing -always set to zero
12	RW	0x0	DIS2P DISABLE2PART 1: Disable two part deferral. Disabling 2-part deferral disables a fast Inter-packet Gap time as described in the 802.3 specification. See ANSI/IEEE Std802.3-1993 Edition , 4.2.3.2.1
11	RW	0x0	PROM PROM 0: normal mode 1: promiscuous mode = accepts all packets.
10	RW	0x0	ENFL ENBFULL 1: enable full duplex mode. This bit needs to be set to the corresponding duplex mode of the PHY chip the VMAC is connected to. The duplex mode of the PHY needs to be polled periodically to keep the VMAC duplex setting in line with the PHY.
9	RO	0x0	reserved
8	RW	0x0	DISBC DISBDCST 1: disable receive broadcast packets.
7:5	RO	0x0	reserved
4	RW	0x0	RXRN RXRUN 0: disable receive operation. If a packet is currently being received, it will complete before the receive operation is disabled. Like TXRN, RXRN can be used to safely disable packet reception.

Bit	Attr	Reset Value	Description
3	RW	0x0	TXRN TXRUN 0: disable transmit operation. This bit is only tested when the TXBDT state machine completes the current transmit operation and just before it checks the next BDT for new packet. This bit can be used to safely stop transmitting packets without affecting packet reception. A TX packet that is already in process will complete before TXRN is recognized.
2:1	RO	0x0	reserved
0	RW	0x0	EN ENABLE 0: stop all activity. 1: enable ethernet traffic. All registers should be initialized before setting this bit. Clearing this bit to zero resets BDT rings to their first BD in the table.

EMAC_POLLRATE

Address: Operational Base + offset (0x0010)

Poll Rate register

Bit	Attr	Reset Value	Description
31:15	RO	0x0	reserved
14:0	RW	0x0000	POLLRATE POLLRATE The value programmed into this register is the number of clocks between polls times 1024. A value of 1 will cause a poll every 1024 clocks. 2=2048 clocks. 0 is not valid. A CPU clock frequency of 100MHz would typically want to program the POLLRATE register with a value of 100 which will cause a poll to occur about once every millisecond ($10\text{ns} * 1024 * 100 = 1\text{ms}$)

EMAC_RXERR

Address: Operational Base + offset (0x0014)

Receive Error Counters

Bit	Attr	Reset Value	Description
31:24	RO	0x0	reserved

Bit	Attr	Reset Value	Description
23:16	RW	0x00	RXOFLOW Overflow Errors Number of receive packets dropped due to FIFO overflows
15:8	RW	0x00	RXFRAM RXFRAME Errors Number of receive packets dropped due to framing errors.
7:0	RW	0x00	RXCRC CRC Errors Number of receive packets dropped due to CRC errors.

EMAC_MISS

Address: Operational Base + offset (0x0018)

Missed Packet Counter

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved
7:0	RW	0x00	MISSCNTR Missed packet counter When the counter counts up to the maximum value, it sets the MISSERR bit in the INTER register. This counter counts the number of packets that were dropped because a BD was not available. This counter is auto-zeroed when read.

EMAC_TXRINGPTR

Address: Operational Base + offset (0x001c)

Transmit Ring Pointer address register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	TXRINGPTR Address of the start of the Transmit RING of Buffer Descriptors Address of the start of the Transmit RING of Buffer Descriptors. Must be on 8-byte boundaries. (ID: Bits 2-0 must be zero)

EMAC_RXRINGPTR

Address: Operational Base + offset (0x0020)

Receive Ring Pointer address register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	RXRINGPTR Address of the start of the Receive RING of BDs. Address of the start of the Receive RING of BDs. Must be on 8-byte boundaries (IE : Bits 2-0 must be zero)

EMAC_ADDR

Address: Operational Base + offset (0x0024)

Ethernet MAC Address , low 32 bits

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	ADDR Lower 32 bits of the ethernet MAC address Lower 32 bits of the ethernet MAC address. The address is little-endian. Thus the first byte transferred on the Ethernet wire must match bits 7:0. The second byte transferred is in bits 15:8 and so on. Thus for a Physical address transmitted in byte order of: 0x00 - 1st byte transmitted 0x11 - 2nd byte transmitted 0x22 - 3rd byte transmitted 0x33 - 4th byte transmitted 0x44 - 5th byte transmitted 0x55 - 6th byte transmitted The ADDR register should be programmed with 0x33221100. Bit 0 is the multi-cast / Broadcast bit of the address. Bit 0 MUST be programmed with a zero.

EMAC_ADDRH

Address: Operational Base + offset (0x0028)

Ethernet MAC Address, high 16 bits

Bit	Attr	Reset Value	Description
31:16	RO	0x0	reserved

Bit	Attr	Reset Value	Description
15:0	RW	0x0000	ADDRH Upper 16 bits of the ethernet MAC address Upper 16 bits of the ethernet MAC address. See ADDRL for more details. In the example given in ADDRL, this register would be programmed with 0x5544.

EMAC_LAFL

Address: Operational Base + offset (0x002c)

Logical Address filter Register Low

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	LAFL Low 32 bits for the Logical Address Filter Low 32 bits for the Logical Address Filter. Each bit corresponds to a hash function of the destination address of a packet. IFF the bit is set to a 1, then the packet is accepted, otherwise it is filtered out.

EMAC_LAFH

Address: Operational Base + offset (0x0030)

Logical Address filter Register High

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	LAFH High 32 bits for the Logical Address Filter High 32 bits for the Logical Address Filter. Each bit corresponds to a hash function of the destination address of a packet. If the bit is set to a 1, then the packet is accepted , otherwise it is filtered out.

EMAC_MDIO_DATA

Address: Operational Base + offset (0x0034)

MDIO access register

Bit	Attr	Reset Value	Description
31:30	RW	0x0	SFD Start of Frame Delimiter Start of Frame Delimiter, must be set to "01"
29:28	RW	0x0	OP Operation Code Operation Code, set to "10" for a read and "01" for a write.

Bit	Attr	Reset Value	Description
27:23	RW	0x00	PHY PHY address(0-31) PHY address(0-31)
22:18	RW	0x00	REG Register to access (0-31) Register to access (0-31)
17:16	RW	0x0	TA Bus Turn-Around, must be set to "10" Bus Turn-Around, must be set to "10"
15:0	RW	0x0000	DATA DATA to be written to or read from the PHY register DATA to be written to or read from the PHY register

EMAC_TXRINGPTR_READ

Address: Operational Base + offset (0x0038)

Transmit Ring Pointer read-back register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	TXRINGPTR Transmit Ring Pointer read-back register This read-only register gives the address of the current Transmit Buffer Descriptor being polled or processed by the VMAC. This allows the software to determine where in the BDT ring the VMAC is currently processing. Note that this is a hardware register and undergoes rapid changes. The value in this register should ONLY be read when TXRN is cleared to zero so that the VMAC will stop processing buffers.

EMAC_RXRINGPTR_READ

Address: Operational Base + offset (0x003c)

Receive Ring Pointer read-back register

Bit	Attr	Reset Value	Description
------------	-------------	--------------------	--------------------

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	RXRINGPTR Receive Ring Pointer read-back register This read-only register gives the address of the current Receive Buffer Descriptor being polled or processed by the VMAC. This allows the software to determine where in the BDT ring the VMAC is currently processing buffers.

31.4 Timing Diagram

- Management Timing Diagram

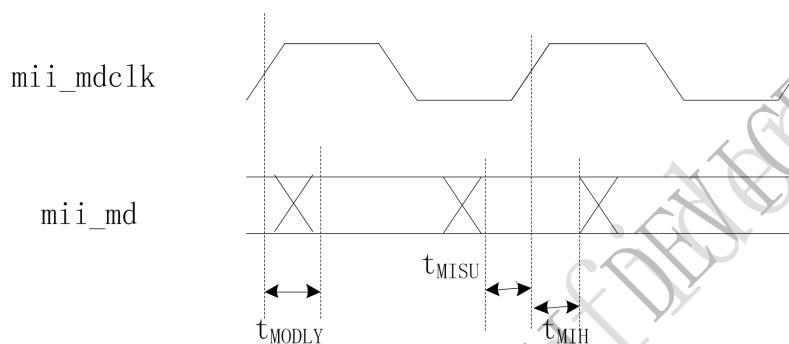


Fig. 31- 5 Management timing diagram

Table 31- 1 Management timing parameters

Parameter	Description	min	typ	max	unit
T _{MDC}	MDC clock period	400	-	-	ns
t _{MODLY}	Mii_md output delay time from mii_mdclk rising edge	261.2			ns
t _{MISU}	Mii_md input setup time from mii_mdclk rising edge	133.3	-	-	ns
t _{MIH}	Mii_md input hold time from mii_mdclk rising edge	0	-	-	ns

- RMII Timing Diagram

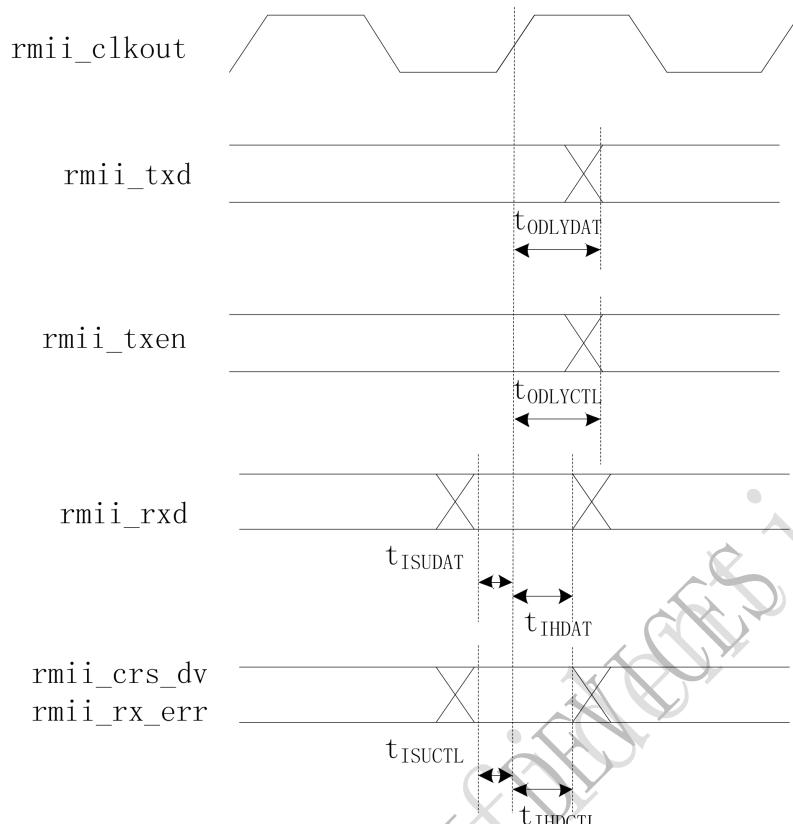


Fig. 31-6 RMII timing diagram

Table 31-2 RMII timing parameters

Parameter	Description	min	typ	max	unit
	Rmii_clkout clock frequency	-	50	-	MHz
$t_{ODLYDAT}$	Rmii txd output delay	4.385	6.764	9.739	ns
$t_{ODLYCTL}$	Rmii control signals output delay	4.902	7.573	11.039	ns
t_{ISUDAT}	rmii_rxd setup to rmii_clkout/rmii_clkin rising edge	3.270	4.401	6.295	ns
t_{IHDAT}	rmii_rxd hold to rmii_clkout/rmii_clkin rising edge	-1.516	-2.195	-3.381	ns
t_{ISUCTL}	rmii_crs_dv, rmii_rx_err setup to rmii_clkout/rmii_clkin rising edge	3.031	4.050	5.822	ns
t_{IHCTRL}	rmii_crs_dv, rmii_rx_err hold to rmii_clkout/rmii_clkin rising edge	-1.572	-2.265	-3.480	ns

31.5 Interface Description

Table 31-3 RMII/MII Interface Description

Module pin	Direction	Pad name	IOMUX

RMII interface			
rmii_clkout	O	GPIO3_C[5]	GRF_GPIO3C_IOMUX[11:10]=10
rmii_clkin	I	GPIO3_C[5]	GRF_GPIO3C_IOMUX[11:10]=11
rmii_tx_en	O	GPIO3_C[0]	GRF_GPIO3C_IOMUX[1:0]=10
rmii_txd1	O	GPIO3_C[1]	GRF_GPIO3C_IOMUX[3:2]=10
rmii_txd0	O	GPIO3_C[2]	GRF_GPIO3C_IOMUX[5:4]=10
rmii_rx_err	I	GPIO3_C[6]	GRF_GPIO3C_IOMUX[13:12]=10
rmii_crs_dv	I	GPIO3_C[7]	GRF_GPIO3C_IOMUX[15:14]=10
alid			
rmii_rxd1	I	GPIO3_C[4]	GRF_GPIO3C_IOMUX[9:8]=01
rmii_rxd0	I	GPIO3_C[3]	GRF_GPIO3C_IOMUX[7:6]=01
Management interface			
mii_md	I/O	GPIO3_D[0]	GRF_GPIO3D_IOMUX[1:0]=10
mii_mdclk	O	GPIO3_D[1]	GRF_GPIO3D_IOMUX[3:2]=10

31.6 Application Notes

31.6.1 Buffer Descriptors

Data is sent and received via buffers that are built in system memory. These buffers are pointed to by the Buffer Descriptor Rings that are also located in memory. These are two Buffer Descriptor Rings: the transmit (TX) and receive (RX) rings. The Transmit Ring Pointer (TXRINGPTR) is a pointer to the start of the Transmit Descriptor Ring. The RXRINGPTR register similarly is a pointer to the start of the Receive Descriptor Ring. The VMAC processes each descriptor in each ring sequentially until it reaches the last descriptor. Then the VMAC will automatically cycle back to the first descriptor in the ring.

Each Buffer Descriptor Ring in turn consists of a number of Buffer Descriptors. The Buffer Descriptor Rings must occupy a contiguous area of memory and must be aligned on 8-byte boundaries. The number of Buffer Descriptors in the Ring are programmed by fields in the CONTROL register.

Each Buffer Descriptor (BD) within the Ring in turn points to a buffer in memory that contains the packet data. Each Buffer Descriptor consists of eight bytes of data formatted as two 32-bit Wrds. The first Wrd (INFO) contains various status information on the buffer itself. The most important field is the OWN bit which indicates whether the VMAC “owns” the buffer, or the processor “owns” the buffer. The OWN bit is a semaphore that indicates who is allowed access to the buffer and the buffer descriptor. If the VMAC owns the buffer, the processor must not make any changes to either the buffer descriptor or the contents of the buffer. If the processor owns the buffer then the VMAC will ignore the buffer and wait for the processor to release it. Once a buffer and the Buffer Descriptor have been prepared, the processor toggles the OWN bit and releases the buffer to the VMAC. The second Wrd of the BD is the PTR field which is a 32-bit byte addressable pointer to the packet data. The data can start on any byte boundary and need not be aligned. Any number of bytes of data can be contained in the buffer, every zero bytes. The length of the buffer is defined in the LENGTH field of the INFO Wrd. A buffer typically contains all of the bytes of a single packet.

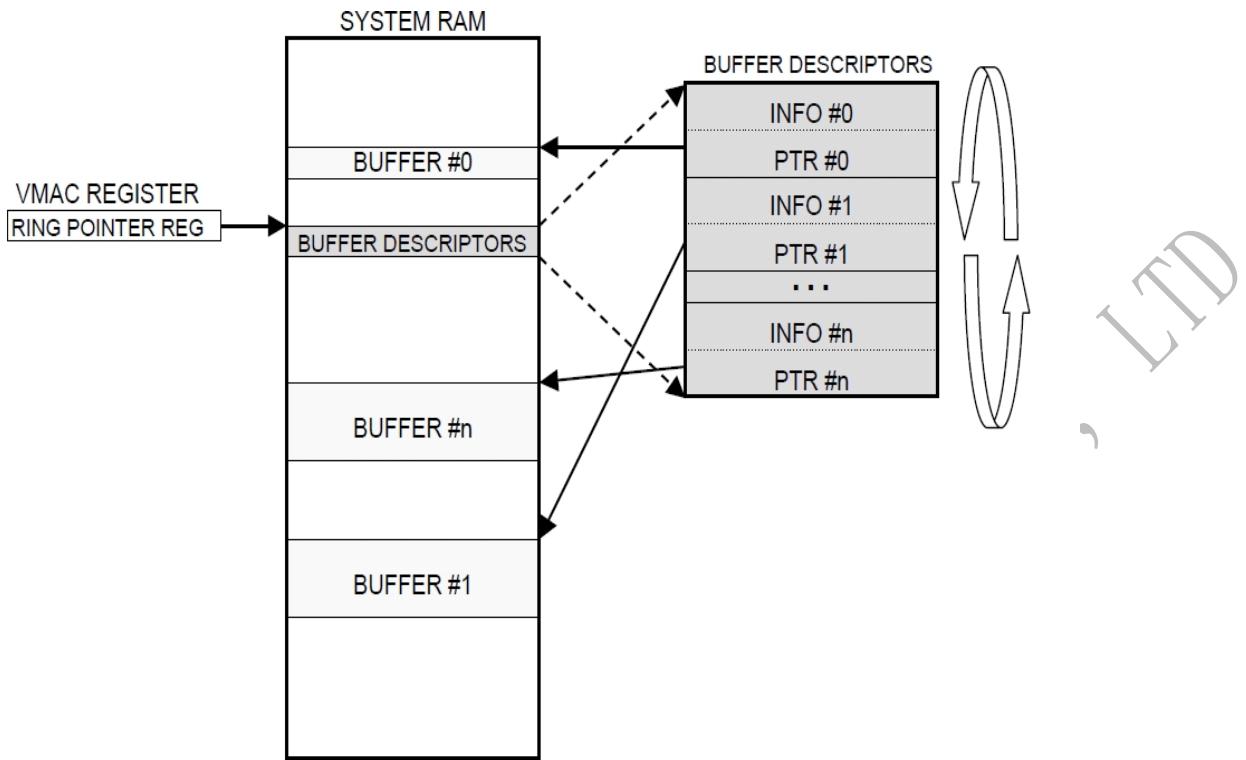


Fig. 31-7 VMAC buffer chain

Fig. 32-9 shows the relationship of the VMAC registers and the Buffer Descriptors. The RINGPTR register is shown on the left which points to the starting address of the Buffer Descriptor Ring (either TX or RX) in system memory. The Buffer Descriptor Ring takes up a very small amount of the system memory and is expanded on the right of the diagram. The Buffer Descriptor Ring has a number of Buffer Descriptors in it each containing the two 32-bit Wrds, INFO and PTR. The PTR in turn points to the start of buffer data which can be in any location in system memory. The VMAC processes one Buffer Descriptor after the next in the ring. When the last BD has been processed, it circles back to the beginning of the ring and continues processing from there.

31.6.2 Transmit Buffer Descriptor

The Transmit Buffer descriptor consists of two 32-bit Wrds, the INFO and PTR Wrds. The INFO Wrd is broken up into a number of smaller fields described on the following page. Note that the processor fills the INFO field with one set of data, and then release the buffer to the VMAC by setting the OWN bit. Once the VMAC has completed processing this buffer, it will fill the INFO Wrd with different data and clear the OWN bit.

The processor must completely set up the Buffer Descriptor and completely fill the buffer with data before setting the OWN bit. Once the OWN bit is set, the processor must not alter the BD or buffer data. Once the OWN bit is set the VMAC will clear the OWN bit once the buffer has been sent or error condition has occurred.

1. Transmit Buffer Descriptor written by CPU

Address: 0x00

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
OW N															AD CR	LA ST	FR ST	Reserved												TXLN	

Address: 0x04

32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
POINTER																																

Fig. 31-8 VMAC transmit buffer descriptor written by CPU

The field descriptions for these registers are shown in the following table:

Bit	Attr	Reset Value	Description
63:32	RW	0x0	POINTER: 32 bit physical address to the start of the buffer data. Does not have to be Wrd aligned. The DMA controller will DMA bytes until it becomes Wrd aligned, then it will transfer Words. Unchanged by VMAC.
31	RW	0x0	OWN 0: buffer owned by the CPU 1: buffer owned by the VMAC
30:19	N/A	0x0	Reserved
18	RW	0x0	ADCR – ADDCRC 1: VMAC will compute and add the 4 byte CRC to the end of the packet. 0: don't add the CRC (FCS) to the end of the packet
17	RW	0x0	LAST – This bit must be set to one when it is the last buffer in a packet. Note that both FIRST and LAST are set at the same time if the buffer is large enough to hold the entire packet
16	RW	0x0	FIRST – This bit must be set to one when it is the first buffer in a packet
15:11	N/A	0x0	Reserved
10:0	RW	0x0	TXLEN – length of data in this buffer to be transmitted. Can be zero length in the case of packet-chaining, but the minimum length for a packet is 64 bytes.

2. Transmit Buffer Descriptor Written by VMAC

Address: 0x00

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
OW N	R	UF I0 CI	LT RTRY	DR OP	DE FR	CR IS	R	AD CR	LA ST	FR ST	Reserved																		TXLN		

Address: 0x04

32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
POINTER																																

Fig. 31-9 VMAC transmit buffer descriptor written by VMAC

The field descriptions for these registers are shown in the following table:

Table 31- 4 VMAC tx buffer descriptor

Bit	Attr	Reset Value	Description
63:32	R	0x0	POINTER: 32 bit physical address to the start of the buffer data. Does not have to be Wrds aligned. The DMA controller will DMA bytes until it becomes Wrds aligned, then it will transfer Wrds. Unchanged by VMAC.
31	RW	0x0	OWN – Cleared by VMAC. When this bit is cleared, the TXINT bit is set if END is also set and the transmission has complete.
30	N/A	0x0	Reserved
29	RW	0x0	UFLO – Underflow erRr, packet data corrupted and dropped because data was not available in time. Larger FIFOs, more AHB bus bandwidth or lower system latency required.
28	RW	0x0	LATECOL – Late collision error – Packet dropped due to late collision
27:24	RW	0x0	RTRY – Retry count, Number of times the packet was retried. Packet transmission is attempted up to 16 times. If the packet is transmitted successfully on the first try, the value is zero.
23	RW	0x0	DRP – More than 16 retransmissions were attempted and the packet was dropped
22	RW	0x0	DEFR – Transmission was deferred due to traffic on the wire
21	RW	0x0	CRLS- Carrier sense was lost during transmission
20:19	N/A	0x0	Reserved
18	R	0x0	ADCR – ADDCRC 1: VMAC will compute and add the 4 byte CRC to the end of the packet. 0: don't add the CRC (FCS) to the end of the packet
17	R	0x0	LAST – This bit is one when it is the last buffer in a packet.
16	R	0x0	FIRST – This bit is one when it is the first buffer in a packet
15:11	N/A	0x0	Reserved
10:0	R	0x0	TXLEN – length of data in this buffer to be transmitted.

31.6.3 Receive Buffer Descriptor

The receive buffer descriptor is very similar to the Transmit Buffer Descriptor and again consists of two 32-bit Words, the INFO and PTR Words. The INFO Wrds is broken up into a number of smaller fields described on the following page.

Note that the processor fills the INFO field with one set of data, and then releases the buffer to the VMAC by setting the OWN bit. Once the VMAC has completed processing this buffer, it will fill the INFO Wrds with different data and clear the OWN bit.

The processor must completely set up the Buffer Descriptor before setting the OWN bit. The data buffer can be left uninitialized as VMAC will fill it with data

once a packet has been received. Once the OWN bit is set, the processor must NOT alter the Buffer Descriptor. Once the OWN bit is set the VMAC may begin operating on the buffer immediately. The VMAC will clear the OWN bit once the buffer has been filled with data or an error condition has occurred.

1.Receive Buffer Descriptor Written by VMAC

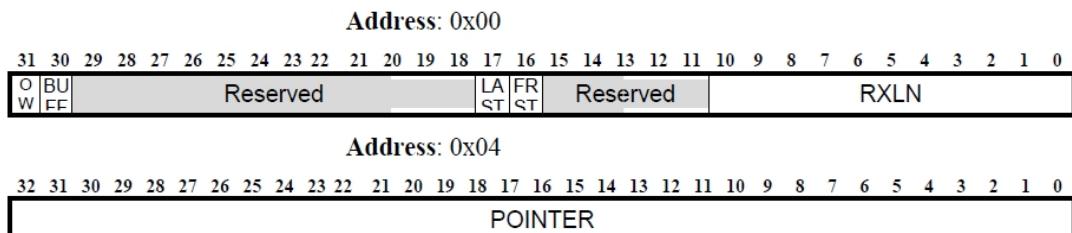


Fig. 31- 10 VMAC receive buffer descriptor written by VMAC

The field descriptions for this register are shown below.

Table 31- 5 VMAC- rx buffer descriptor for VMAC

Bit	Attr	Reset Value	Description
63:32	R	0x0	POINTER: 32 bit physical address to the start of the buffer data. Does not have to be Word aligned. The DMA controller will DMA bytes until it becomes Wrd aligned, then it will transfer Wrds.
31	RW	0x0	OWN 0: buffer owned by the CPU 1: buffer owned by the VMAC This bit is cleared by VMAC. When this bit is cleared and LAST is set to 1, the RXINT bit is set.
30	RW	0x0	BUFF – Buffer error, an error occurred during packet chaining, with data in one or more of the buffers in the chain corrupted. Software should discard the entire packet and return the buffers back to the VMAC.
29:18	N/A	0x0	Reserved
17	RW	0x0	LAST – This bit must be set to one when it is the last buffer in a packet.
16	RW	0x0	FIRST – This bit must be set to one when it is the first buffer in a packet. Note that in certain error conditions, you may come across a FIRST bit being set without a corresponding END. In this case the previous packet must be dropped.
15:11	N/A	0x0	Reserved
10:0	RW	0x0	RXLEN – Length of the data in this buffer in bytes. Might be zero length. Note that if a packet of exactly the same length as the RXLEN is received, there is a chance that the VMAC will release the buffer without the LAST bit set in anticipation of using buffer chaining. The next buffer will be released with the LAST bit set but will be zero length. This is especially true when the CPU

is clocking much faster than the VMAC. To prevent chaining, the CPU should set RXLEN to a slightly larger value than the largest expected packet length.

2. Receive Buffer Descriptor Written by CPU

Address: 0x00

Address: 0x04

32 31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
POINTER

Fig. 31- 11 VMAC receive buffer descriptor written by CPU

The field descriptions for this register are shown below.

Table 31- 6 VMAC-rx buffer descriptor for CPU

Bit	Attr	Reset Value	Description
63:32	R	0x0	POINTER: 32 bit physical address to the start of the buffer data. Does not have to be word aligned. The DMA controller will DMA bytes until it becomes Wrld aligned, then it will transfer Wrds.
31	RW	0x0	OWN 0: Buffer owned by the CPU 1: Buffer owned by the VMAC
30:18	N/A	0x0	Reserved
17	RW	0x0	LAST – This bit is one when it is the last buffer in a packet. CPU clears it to zero.
16	RW	0x0	FIRST – This bit is one when it is the first buffer in a packet, CPU clears it to zero
15:11	N/A	0x0	Reserved
10:0	RW	0x0	RXLEN – Maximum length of data in this buffer in bytes. Can be zero but strongly discouraged. Minimum of 64 bytes recommended. 1536 recommended unless using chaining.

31.6.4 Buffer Chaining

The length of each buffer is defined in the RXLEN or TXLEN fields within the INFO Wrd of each Buffer Descriptor. The length of a buffer can be between zero and 2047 bytes though buffer of less than 64 bytes are strongly discouraged. Larger FIFOs are highly recommended when using buffer chaining.

Buffer chaining is also useful for receive packets by using more buffers of smaller sizes. Chaining allows the use of smaller buffers which in turn creates more buffers in the same amount of memory. More receive buffers means there is a lower chance of dropping important short packets and relying on upper level software to transmit the dropped packets. Note that by chaining buffers you can still assemble the packet data to be contiguous for large packets.

31.6.5 Automatic Descriptor Polling

The TX and RX BDT rings will be polled at the frequency programmed into the POLLRATE register. The DMA controller polls the BDT rings to see if the next descriptors in the chain are owned by the VMAC. There are also several instances where automatic polling of the descriptor chains will occur.

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Chapter 32 High-Speed ADC /TS stream Interface

32.1 Overview

HS-ADC Interface Unit is interface unit for connecting the High Speed AD Converter to AMBA AHB bus. That implement bus speed convert at low speed AD Converter bus to high speed AHB bus. HS-ADC Interface Unit fetches the bus data by the AD converter and stores that to asynchronous FIFO after the AD clock is active when OS configure completion by DMA and HS-ADC Interface Unit. The HS-ADC Interface Unit generates the DMA request signal when data length of the asynchronous FIFO over the almost full level or almost empty level.

32.1.1 Features

- Support HS-ADC interface with 8bits/10bits data bus
- Support Transport-Stream Interface with 8bits data bus
- Support GPS interface with 2bits/4bits data bus
- Support combined interrupt output, the source includes:full interrupt, empty interrupt
- Support DMA transfers mode and that generate DMA request from the event of almost full or almost empty, etc.
- Support two channel mode:single channel and dual channel
- Support the most significant bit negation or not
- Support sign bitextention
- Support two store mode: store to high 8bits/10bits and store to low 8bits/10bits
- Support an asynchronous build-in FIFO with 128x64 size
- Support AHB burst transfer, including SINGLE, INCR4, INCR8, INCR16

32.2 Block Diagram

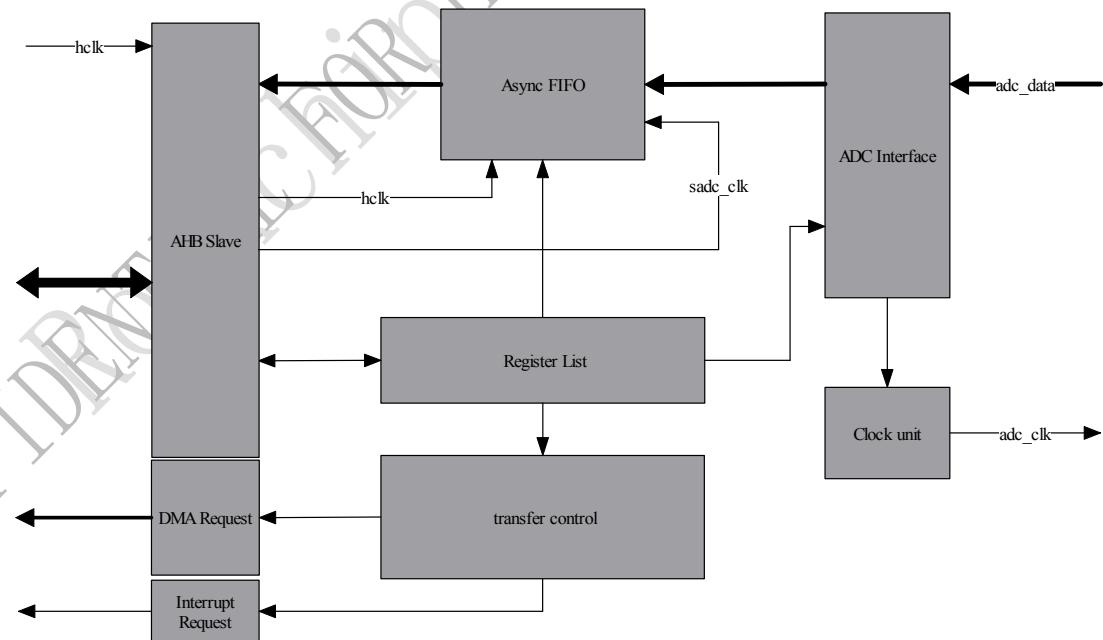


Fig. 32-1 HS-ADC/TS Interface block diagram

32.3 Function Description

This module can be configured for 3 interfaces:

1. HS-ADC interface
2. GPS interface
3. TS interface

1. HS-ADC interface

When this module is used as HS-ADC interface, user should configure GRF_GPIO2B_IOMUX and GRF_GPIO2C_IOMUX to select HS-ADC data input, and select hsadc_clock input(pgs_clkin) from pad or output hsadc_clock(hsadc_clkout) to pad. The direction of hsadc_clock is determined by software through configuring CRU_CLKSEL_CON[5:4].

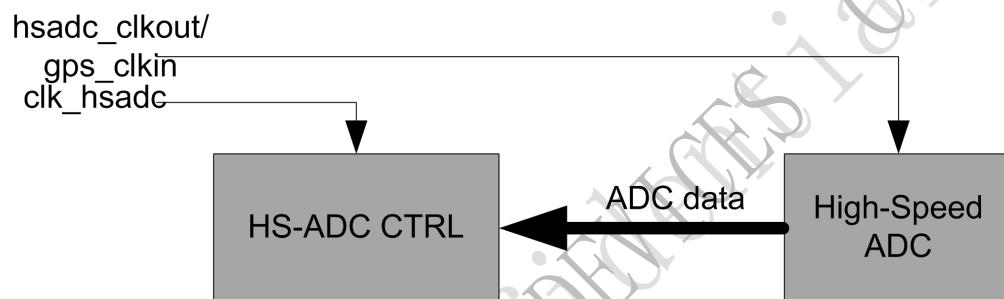


Fig. 32- 2 HS-ADC application diagram

2. GPS interface

When this module is used as GPS interface, user should configure GRF_GPIO2C_IOMUX to select 2bits or 4bits GPS data input and gps_clk as GPS clock input from pad.

Also, user should configure CRU_CLKSEL_CON[5:4] to select gps_clk as HS-ADC controller working clock source.

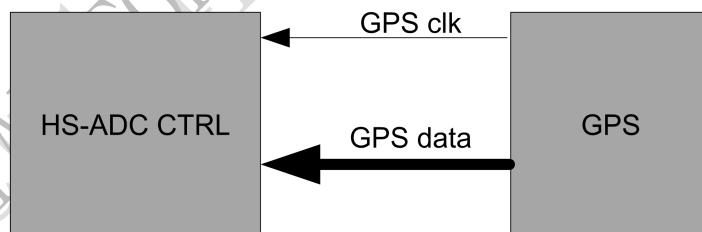


Fig. 32- 3 GPS application diagram

3. TS interface

When this module is used as TS interface, user should configure GRF_GPIO2B_IOMUX and GRF_GPIO2C_IOMUX to select 8bit TS data, ts_sync, ts_valid and ts_fail input and gps_clk input as TS clock input from pad.

Also, user should configure CRU_CLKSEL_CON[5:4] to select gps_clk from pad as TS clock input.

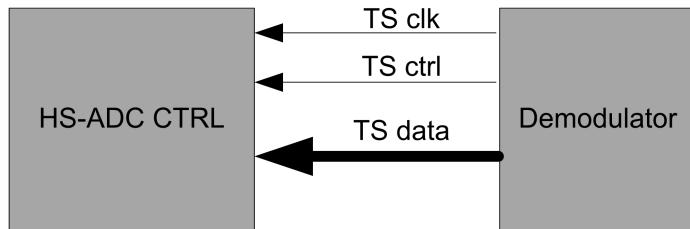


Fig. 32- 4 TS application diagram

32.4 Register Description

32.4.1 Registers Summary

Name	Offset	Size	Reset Value	Description
HSADC_CTRL	0x00	RW	0x00000000	control register
HSADC_IER	0x04	RW	0x00000000	interrupt enable/mask register
HSADC_ISR	0x08	RW	0x00000000	interrupt status register
HSADC_TS_FAIL	0x0c	R	-	ts fail register
HSADC_DATA	0x10	R	-	data register

32.4.2 Detail Register Description

HSADC_CTRL

Address: Operational Base + offset (0x0000)

Control register

Bit	Attr	Reset Value	Description
31:28	RO	0x0	reserved
27:24	RW	0x0	almost_full_level Define almost full trigger level 0x0~"0xf" - configure valid range (Notes: 1 level indicate 4 entries data in the async FIFO. and this configure range mapping to 64 - 124 entries data in the async FIFO.)
23:20	RO	0x0	reserved
19:16	RW	0x0	almost_empty_level Define almost empty trigger level 0x0~"0xf" - configure valid range (Notes: 1 level indicate 4 entries data in the async FIFO. and this configure range mapping to 0 - 60 entries data in the async FIFO.)
15:13	RO	0x0	reserved
12	RW	0x0	sbex Sign Bit extent select Sign bit extent select when store width wider than interface width 0: fill 0 1: fill sign extend bit

Bit	Attr	Reset Value	Description
11	RW	0x0	gpsw GPS interface data width select 0:2bit data mode 1:4bit data mode
10	RW	0x0	ts_sync_en TS sync interface enable Field0000 Description
9	RW	0x0	ts_valid_en TS valid interface enable Enable ts interface "ts_valid" signal as data valid indicator 0:disable 1:enable
8	RW	0x0	ts_sel MPEG-TS input select 0 : MPEG-TS is Not selected 1 : MPEG-TS is selected *When gps_sel & ts_sel both equal to 0,then ADC IF is selected
7	RW	0x0	chan data input channel select 0 : single channel, ADC input from adc_data_l 1 : double channel data input from adc_data_l/adc_data_h
6	RW	0x0	stmd Store mode select 0:8bit store mode 1:16bit store mode
5	RW	0x0	dma_req_mode DMA request mode select 1 - almost full generate DMA request signal (Notes: this mode generate DMA request signal from almost full condition and cancel DMA request signal from almost empty condition. so you need configure two level by almost full level and almost empty level) 0 - almost empty generate DMA request signal (Notes: this mode generate DMA request signal from almost empty condition and that only once DMA request.)

Bit	Attr	Reset Value	Description
4	RW	0x0	smsb MSB negation select 1:negation 0:not negation
3	RW	0x0	sctl store mode select fetch the bus data by AD converter and that store to high 8-bit/10-bit or low 8-bit/10-bit at a haft word width before push to Async FIFO: "1" - store to high 8-bit/10-bit "0" - store to low 8-bit/10-bit (Notes: have sign extend if that configure of store to low 8-bit/10-bit)
2	RW	0x0	bwth The data bus width of AD converter "1" - 10-bit "0" - 8-bit
1	RW	0x0	gps_sel GPS input select 0 : GPS is Not selected 1 : GPS is selected *When gps_sel & ts_sel both equal to 0,then ADC IF is selected
0	RW	0x0	adc_en HS-ADC Interface Unit Enable Bit "1" - enable (Notes: will return 1 when the hardware started transfer) "0" - disable (Notes: other bit can be modify only the hardware return 0)

HSADC_IER

Address: Operational Base + offset (0x0004)

Interrupt control register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x0	int_empty_en Interrupt en/disable bit for the empty interrupt flag of async FIFO "1" - enable "0" - disable

Bit	Attr	Reset Value	Description
0	RW	0x0	int_full_en Interrupt en/disable bit for the full interrupt flag of async FIFO "1" - enable "0" - disable

HSADC_ISR

Address: Operational Base + offset (0x0008)

Interrupt status register

Bit	Attr	Reset Value	Description
31:2	RO	0x0	reserved
1	RW	0x0	int_empty_stat_ind Async FIFO empty interrupt flag "1(R)" - This bit will be set to "1" when Async FIFO empty status and that only to read operation. "0(W)" - Write "0" to bit for clear the interrupt flag and that only to write operation.
0	RW	0x0	int_full_stat_ind Async FIFO full interrupt flag . "1(R)" - This bit will be set to "1" when Async FIFO full status and that only to read operation. "0(W)" - Write "0" to bit for clear the interrupt flag and that only to write operation.

HSADC_TS_FAIL

Address: Operational Base + offset (0x000c)

ts fail register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RW	0x0	ts_fail_ahb TS stream fail indicator this signal only valid when select TS stream input(mpts=1) 0:TS stream decode successfully 1:TS stream decode fail

HSADC_CGCTL

Address: Operational Base + offset (0x0010)

HSADC Clock Gating control

Bit	Attr	Reset Value	Description
31:1	RW	0x00000000	cycle_cfg clock gated cycles configuration when configure cg_enable to 1 and cycle_cfg to non-zero value, HSADC clock will be gated for cycle_cfg cycles, then clock recover.
0	RW	0x0	cg_enable clock gating enable control 0:clock gating disable 1:clock gating enable

HSADC_DATA

Address: Operational Base + offset (0x0020)

Data register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	DATA DATA DATA

32.5 Timing Diagram

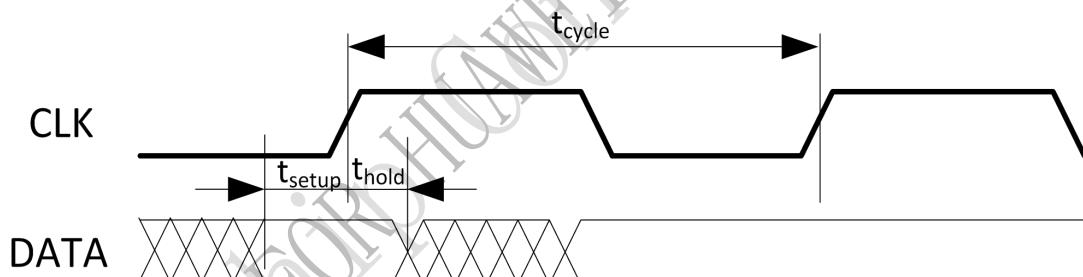


Fig. 32- 5 HS-AD Interface timing diagram

Table 32- 1 HS-ADC interface timing parameter

Master Mode

Parameter	Symbol	Min	Typ	Max	Unit
Clock Cycle	t_{cycle}	15	15	15	ns
Data to clock setup time	t_{setup}	3.279	4.245	6.331	ns
Data to clock hold time	t_{hold}	0	0	0	ns

Slave Mode

Parameter	Symbol	Min	Typ	Max	Unit
Clock Cycle	t_{cycle}	22.5	22.5	22.5	ns
Data to clock setup time	t_{setup}	4.512	5.030	5.669	ns
Data to clock hold time	t_{hold}	0	0	0	ns

Note: When interface configured as TS or GPS interface, CLK is input from pad, when configured as ADC interface, CLK is output to pad.

32.6 Interface Description

The following are typical iomux configurations.

For more information, please reference detailed register description in GRF chapter.

In ADC mode:

Table 32- 2 IOMUX configuration in ADC mode

Module Pin	Direction	Pad Name	IOMUX Setting
hsadc_clkout/ gps_clkin	O/ I	CIF_CLKIN	GRF_SOC_CON0[14]=1'b1
adc_data_i[0]	I	CIF_DATA[2]	GRF_SOC_CON0[14]=1'b1
adc_data_i[1]	I	CIF_DATA[3]	GRF_SOC_CON0[14]=1'b1
adc_data_i[2]	I	CIF_DATA[4]	GRF_SOC_CON0[14]=1'b1
adc_data_i[3]	I	CIF_DATA[5]	GRF_SOC_CON0[14]=1'b1
adc_data_i[4]	I	CIF_DATA[6]	GRF_SOC_CON0[14]=1'b1
adc_data_i[5]	I	CIF_DATA[7]	GRF_SOC_CON0[14]=1'b1
adc_data_i[6]	I	CIF_DATA[8]	GRF_SOC_CON0[14]=1'b1
adc_data_i[7]	I	CIF_DATA[9]	GRF_SOC_CON0[14]=1'b1
adc_data_i[8]	I	GPIO3_B[4]	GRF_GPIO3B_IOMUX[9:8]=2'b10
adc_data_i[9]	I	GPIO3_B[5]	GRF_GPIO3B_IOMUX[11:10]=2'b10

In GPS mode:

Table 32- 3 IOMUX configuration in GPS mode

Module Pin	Direction	Pad Name	IOMUX Setting
gps_clkin	I	CIF_CLKIN	GRF_SOC_CON0[14]=1'b1
adc_data_i[0]	I	CIF_DATA[2]	GRF_SOC_CON0[14]=1'b1
adc_data_i[1]	I	CIF_DATA[3]	GRF_SOC_CON0[14]=1'b1
adc_data_i[2]	I	CIF_DATA[4]	GRF_SOC_CON0[14]=1'b1
adc_data_i[3]	I	CIF_DATA[5]	GRF_SOC_CON0[14]=1'b1

In TS mode:

Table 32- 4 IOMUX configuration in TS mode

Module Pin	Direction	Pad Name	IOMUX Setting
gps_clkin	I	CIF_CLKIN	GRF_SOC_CON0[14]=1'b1
adc_data_i[0]	I	CIF_DATA[2]	GRF_SOC_CON0[14]=1'b1
adc_data_i[1]	I	CIF_DATA[3]	GRF_SOC_CON0[14]=1'b1
adc_data_i[2]	I	CIF_DATA[4]	GRF_SOC_CON0[14]=1'b1
adc_data_i[3]	I	CIF_DATA[5]	GRF_SOC_CON0[14]=1'b1
adc_data_i[4]	I	CIF_DATA[6]	GRF_SOC_CON0[14]=1'b1
adc_data_i[5]	I	CIF_DATA[7]	GRF_SOC_CON0[14]=1'b1
adc_data_i[6]	I	CIF_DATA[8]	GRF_SOC_CON0[14]=1'b1
adc_data_i[7]	I	CIF_DATA[9]	GRF_SOC_CON0[14]=1'b1
ts_valid	I	GPIO3_B[4]	GRF_GPIO3B_IOMUX[9:8]=2'b10
ts_fail	I	GPIO3_B[5]	GRF_GPIO3B_IOMUX[11:10]=2'b10
ts_sync	I	CIF_VSYNC	GRF_SOC_CON0[14]=1'b1

32.7 Application Notes

The following sections will describe the operation of DMA requests and DMA transfers:

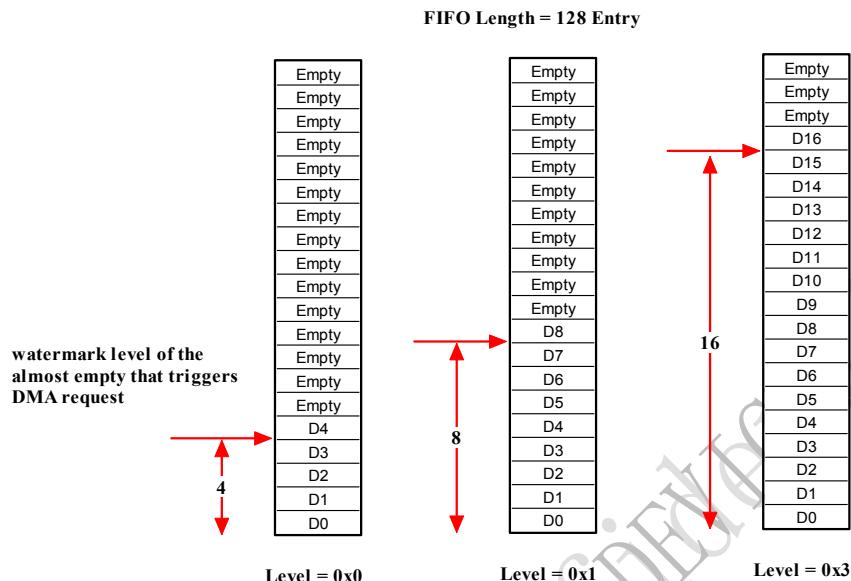


Fig. 32- 6 Almost empty triggers a DMA request by DMA request mode

The DMA request signal will be generated from a watermark level trigger when data stored to FIFO over the watermark level of almost empty, where the watermark level can be configured through HSADC_CTRL[19:16] by software. This DMA request mode doesn't care the watermark level of almost full. The sample for watermark level configuration is shown in figure above.

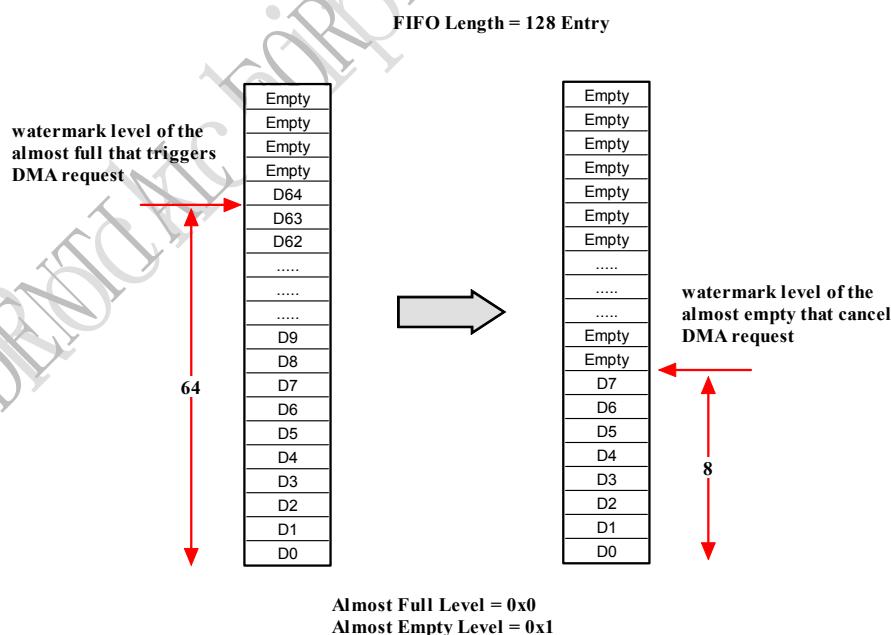


Fig. 32- 7 Almost full triggers a DMA request by DMA request mode

The DMA request signal will be generated from a watermark level trigger when data stored to FIFO over the watermark level of almost full. It continues to

generate request signal when the number of data in FIFO greater than watermark level of almost empty. This DMA request mode needs configures two watermark levels: watermark level of almost empty at the HSADC_CTRL[19:16] and watermark level of almost full at the HSADC_CTRL[27:24]. The sample for watermark level configuration is shown in figure above.

When controller works in TS mode, the interface signal ts_sync should always be used.

Chapter 33 PID-FILTER

33.1 Overview

THE PID Filter controller is used to process the orginial TS(Transport Stream) from HS-ADC. It receives the original TS from HS-ADC, and transport the filtered TS to memory.

33.1.1 Key Feature

- Support 32-bit AHB slave configuration port & buffer write
- Support PID filter up to 64 channels'PID simultaneously
- Support sync-byte detection in transport packet head
- Support 188work x 2 PingPong buffer
- Support combined interrupt and interrupt polarity/type configurable
- Support transfer handshake mechanismwith external DMA
- Support packet lost mechanismwhen bandwidth is limited

33.2 Block Diagram

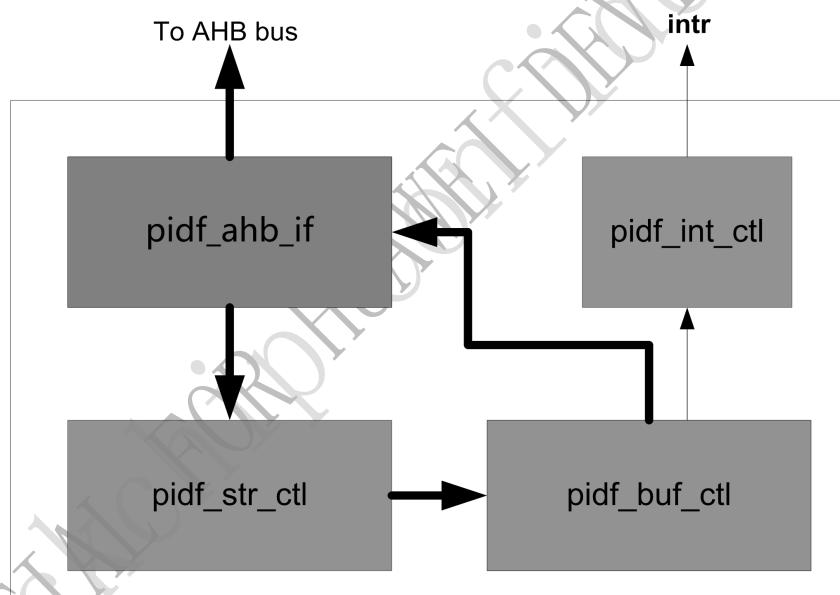


Fig. 33- 1 PID-Filter block diagram

33.3 Function Description

This module is used to co-work with external DMA. The DMA receives raw TS data from HS-ADC controller and transfers them to PID-Filter, then PID-Filter controller filters specific TS packet out and triggers DMA to transfer remaining useful TS packet to memory for future usage.

Besides, when PID-Filter controller receives the unexpected head of TS packet or loses packet in TS receiving procedure, the controller is capable of outputting interrupt to processor.

33.4 Register Description

33.4.1 Register summary

Name	Offset	Size	Reset Value	Description
PIDF_GCTL	0x0000	W	0x00000000	Global Control register
PIDF_GSTA	0x0004	W	0x0000000a	Global Status register
PIDF_ICTL	0x0010	W	0x00000000	Interrupt control register
PIDF_IMR	0x0014	W	0x00000000	Interrupt mask register
PIDF_ICLR	0x0018	W	0x00000000	Interrupt clear register
PIDF_IRSR	0x001C	W	0x00000000	Raw interrupt status(pre-masking) register
PIDF_ISR	0x0020	W	0x00000000	Interrupt status register
PIDF_CHID0	0x0080	W	0x00000000	Filter out ID & enable for channel 0
PIDF_CHID1	0x0084	W	0x00000000	Filter out ID & enable for channel 1
PIDF_CHID2 ~PIDF_CHID6 3	0x0088 ~0x001 7C	W	0x00000000	Filter out ID & enable for channel 2~31
PIDF_DR	0x0200	W	0x00000000	Data buffer write/read entrance

33.4.2 Register description

PIDF_GCTL

Address: Base + offset(0x0000)

The global control register of PID Filter controller

Bit	Attr	Reset Value	Description
31:3	R	0x0	Reserved
2	RW	0x0	Filter function bypass Filter function bypass enable. When set,data write transfer to buffer will not bypass PID filter function.
1	RW	0x0	Hardware handshake mechanism enable 0: Hardware handshake disable 1: Hardware handshake enable
0	RW	0x0	PID filter function enable 0:PID filter disable 1:PID filter enable

PIDF_GSTA

Address: Base + offset(0x0004)

The global status register of PID Filter controller

Bit	Attr	Reset Value	Description
31:4	R	0x0	Reserved
3	R	0x1	Buffer 1 empty indicator Buffer 1 empty status indicator
2	R	0x0	Buffer 1 full indicator Buffer 1 full status indicator

1	R	0x1	Buffer 0 empty indicator Buffer 0 empty status indicator
0	R	0x0	Buffer 0 full indicator Buffer 0 full status indicator

PIDF_ICTL

Address: Base + offset(0x0010)

The interrupt control register of PID filter controller

Bit	Attr	Reset Value	Description
31:3	R	0x0	Reserved
2	RW	0x0	Interrupt type select 0:Edge-type interrupt select 1:Level-type interrupt select
1	RW	0x0	Interrupt polarity select 0: High-active interrupt select for combined int output 1: Low-active interrupt select for combined int output
0	RW	0x0	Interrupt enable 0:Interrupt disable 1:Interrupt enable

PIDF_IMR

Address: Base + offset(0x0014)

The interrupt mask register of PID filter controller

Bit	Attr	Reset Value	Description
31:4	R	0x0	Reserved
3:0	RW	0x0	Interrupt mask for each interrupt source Interrupt mask for each interrupt source 0:Interrupt source mask disable for corresponding interrupt source 1:Interrupt source mask enable for corresponding interrupt source bit0 : Sync byte error interrupt bit1 : Packet lost detected interrupt bit2 : buffer empty interrupt bit3 : buffer full interrupt

PIDF_ICLR

Address: Base + offset(0x0018)

The interrupt clear register of PID filter controller

Bit	Attr	Reset Value	Description
31:4	R	0x0	Reserved
3:0	RW	0x0	Interrupt clear for each interrupt source Interrupt clear for each interrupt source 0 : bit value will be set to "0" after write 1 to it 1 : interrupt clear for corresponding interrupt source bit0 : Sync byte error interrupt

			bit1 : Packet lost detected interrupt bit2 : buffer empty interrupt bit3 : buffer full interrupt
--	--	--	--

PIDF_IRSR

Address: Base + offset(0x001C)

The interrupt raw status register of PID filter controller

Bit	Attr	Reset Value	Description
31:4	R	0x0	Reserved
3:0	R	0x0	Interrupt raw status Interrupt raw status for each interrupt source bit0 : Sync byte error interrupt bit1 : Packet lost detected interrupt bit2 : buffer empty interrupt bit3 : buffer full interrupt

PIDF_ISR

Address: Base + offset(0x0020)

The interrupt status register of PID filter controller

Bit	Attr	Reset Value	Description
31:4	R	0x0	Reserved
3:0	R	0x0	Interrupt status Interrupt status for each interrupt source bit0 : Sync byte error interrupt bit1 : Packet lost detected interrupt bit2 : buffer empty interrupt bit3 : buffer full interrupt

PIDF_CHID0

Address: Base + offset(0x0080)

The pid index and enable for channel 0 of PID filter controller

Bit	Attr	Reset Value	Description
31:17	R	0x0	Reserved
16	RW	0x0	Channel 0 enable 0:Diable to filter out channel ID 0 1:Enable to filter out channel ID 0
15:13	R	0x0	Reserved
12:0	RW	0x0	Channel 0 PID value Channel 0 PID value to filter out

The PID_CHID x register's address offset is $(x*0x4)+0x80$,and the definition of register field is the same as PID_CHID0.

PIDF_DR

Address: Base + offset(0x0200)

The data register of PID filter controller

Bit	Attr	Reset Value	Description
31:0	RW	0x0	PID Filter data register

33.5 Application Notes

33.5.1 Working Flow

Below is the typical data flow:

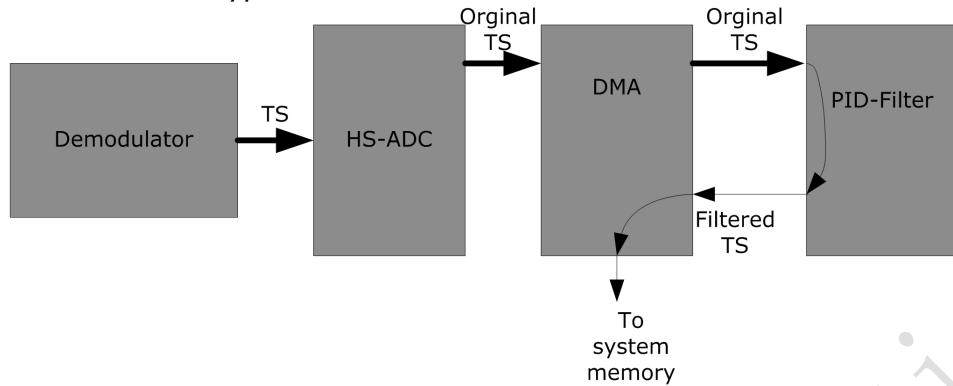


Fig. 33- 2 PID-Filter data flow

Typically, PID-Filter and HS-ADC use hardware-handshake mechanism to transact with DMA.

When start to receiver TS from demodulator, user should follow the below sequence:

- Start DMA to wait for hardware request
- Start PID-Filter to wait for data from HS-ADC
- Start HS-ADC to receiving

When stop to receiver TS from demodulator, user should follow the below sequence:

- StopHS-ADC
- Stop DMA
- Stop PID-Filter

33.5.2 About internal buffer access

The internal ping-pong buffer in PID-Filter cannot be random accessed. User can only accessed the buffer through the register entrance (PIDF_BASE +PIDF_DR) in a particular sequence.

33.5.3 Recommendation

It's recommended to soft reset the PID-Filter controller before restart PID-Filter working.

Chapter 34 SPI Controller

34.1 Overview

The serial peripheral interface is an APB slave device. A four-wire, full-duplex serial protocol from Motorola. There are four possible combinations for the serial clock phase and polarity. The clock phase (SCPH) determines whether the serial transfer begins with the falling edge of slave select signals or the first edge of the serial clock. The slave select line is held high when the SPI is idle or disabled. This SPI controller can work as either master or slave mode.

- Support Motorola SPI,TI Synchronous Serial Protocol and National Semiconductor Microwire interface
- Support 32-bit APB bus
- Support two internal 16-bit wide and 32-location deep FIFOs, one for transmitting and the other for receiving serial data
- Support two chip select signals in master mode
- Support 4,8,16 bit serial data transfer
- Support configurable interrupt polarity
- Support asynchronous APB bus and SPI clock
- Support master and slave mode
- Support DMA handshake interface and configurable DMA water level
- Support transmit FIFO empty, underflow, receive FIFO full, overflow, underflow interrupt and all interrupts can be masked
- Support configurable water level of transmit FIFO empty and receive FIFO full interrupt
- Support combine interrupt output
- Support up to half of SPI clock frequency transfer in master mode and one sixth of SPI clock frequency transfer in slave mode
- Support full and half duplex mode transfer
- Stop transmitting SCLK if transmit FIFO is empty or receive FIFO is full in master mode
- Support configurable delay from chip select active to SCLK active in master mode
- Support configurable period of chip select inactive between two parallel data in master mode
- Support big and little endian, MSB and LSB first transfer
- Support two 8-bit audio data store together in one 16-bit wide location
- Support sample RXD 0~3 SPI clock cycles later
- Support configurable SCLK polarity and phase
- Support fix and incremental address access to transmit and receive FIFO

34.2 Block Diagram

The SPI comprises with:

- AMBA APB interface and DMA Controller Interface
- Transmit and receive FIFO controllers and an FSM controller

- Register block
- Shift control and interrupt

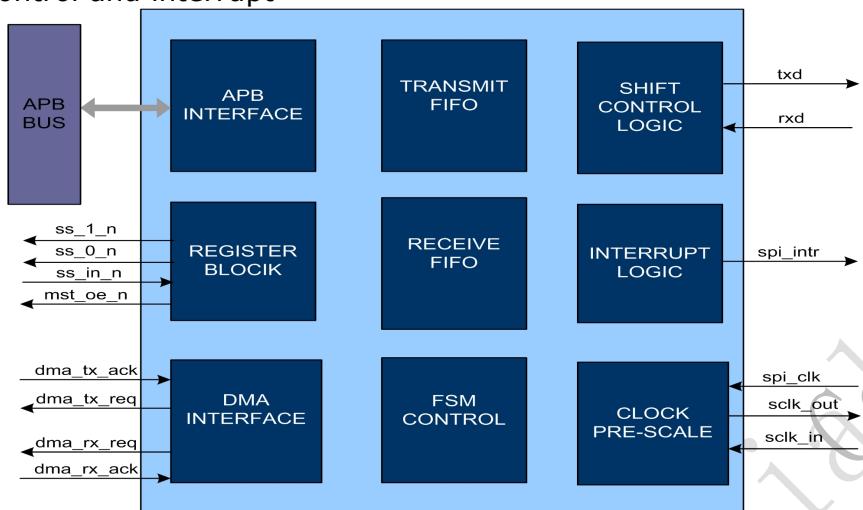


Fig. 34- 1SPI Controller Block diagram

APB INTERFACE

The host processor accesses data, control, and status information on the SPI through the APB interface. The SPI supports APB data bus widths of 8, 16, and 32 bits.

DMA INTERFACE

This block has a handshaking interface to a DMA Controller to request and control transfers. The APB bus is used to perform the data transfer to or from the DMA Controller.

FIFO LOGIC

For transmit and receive transfers, data transmitted from the SPI to the external serial device is written into the transmit FIFO. Data received from the external serial device into the SPI is pushed into the receive FIFO. Both fifos are 32x16bits.

FSM CONTROL

Control the state's transformation of the design.

REGISTER BLOCK

All registers in the SPI are addressed at 32-bit boundaries to remain consistent with the AHB bus. Where the physical size of any register is less than 32-bits wide, the upper unused bits of the 32-bit boundary are reserved. Writing to these bits has no effect; reading from these bits returns 0.

SHIFT CONTROL

Shift control logic shift the data from the transmit fifo or to the receive fifo. This logic automatically right-justifies receive data in the receive FIFO buffer

INTERRUPT CONTROL

The SPI supports combined and individual interrupt requests, each of which can be masked. The combined interrupt request is the ORed result of all other SPI interrupts after masking.

34.3 Function description



Fig. 34- 2SPI Master & Slave Interconnection

The SPI controller support dynamic switching between master and slave in a system. The diagram show how the SPI controller connects with other SPI devices.

- **Operation Modes**

The SPI can be configured in the following two fundamental modes of operation: Master Mode when SPI_CTRLR0 [20] is 1'b0, Slave Mode when SPI_CTRLR0 [20] is 1'b1.

- **Transfer Modes**

The SPI operates in the following three modes when transferring data on the serial bus:

1. Transmit and Receive:

When SPI_CTRLR0 [19:18] = 2'b00, both transmit and receive logic are valid.

2. Transmit Only:

When SPI_CTRLR0 [19:18] = 2'b01, the receive data are invalid and should not be stored in the receive FIFO.

3. Receive Only:

When SPI_CTRLR0 [19:18] = 2'b10, the transmit data are invalid.

- **Clock Ratios**

A summary of the frequency ratio restrictions between the bit-rate clock (sclk_out/sclk_in) and the SPI peripheral clock (spi_clk) are described as:

Master: $F_{spi_clk} \geq 2 \times (\text{maximum } F_{sclk_out})$

Slave: $F_{spi_clk} \geq 6 \times (\text{maximum } F_{sclk_in})$

With the SPI, the clock polarity (SCPOL) configuration parameter determines whether the inactive state of the serial clock is high or low. To transmit data, both SPI peripherals must have identical serial clock phase (SCPH) and clock polarity (SCPOL) values. The data frame can be 4/8/16 bits in length.

When the configuration parameter SCPH = 0, data transmission begins on the falling edge of the slave select signal. The first data bit is captured by the master and slave peripherals on the first edge of the serial clock; therefore, valid data must be present on the txd and rxd lines prior to the first serial clock edge.

Fig.35-3 and Fig.35-4 show a timing diagram for a single SPI data transfer with SCPH = 0. The serial clock is shown for configuration parameters SCPOL = 0 and SCPOL = 1.

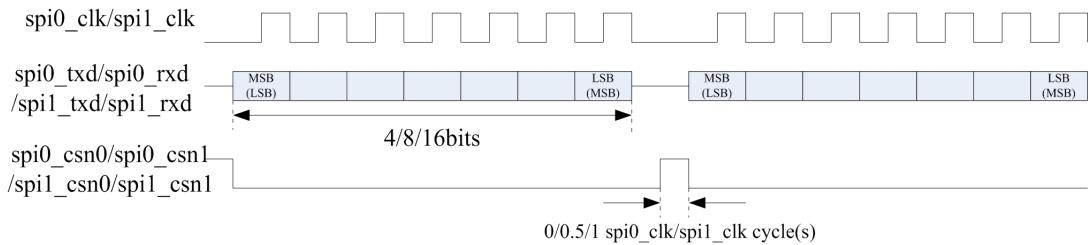


Fig. 34- 3 SPI Format (SCPH=0 SCPOL=0)

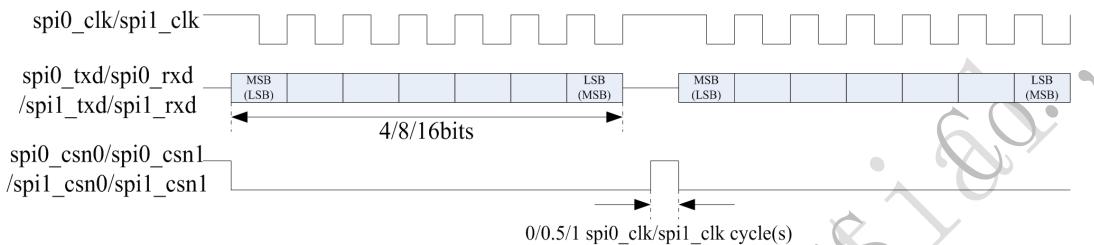


Fig. 34- 4SPI Format (SCPH=0 SCPOL=1)

When the configuration parameter SCPH = 1, both master and slave peripherals begin transmitting data on the first serial clock edge after the slave select line is activated. The first data bit is captured on the second (trailing) serial clock edge. Data are propagated by the master and slave peripherals on the leading edge of the serial clock. During continuous data frame transfers, the slave select line may be held active-low until the last bit of the last frame has been captured. Fig.35-5 and Fig.35-6 show the timing diagram for the SPI format when the configuration parameter SCPH = 1.

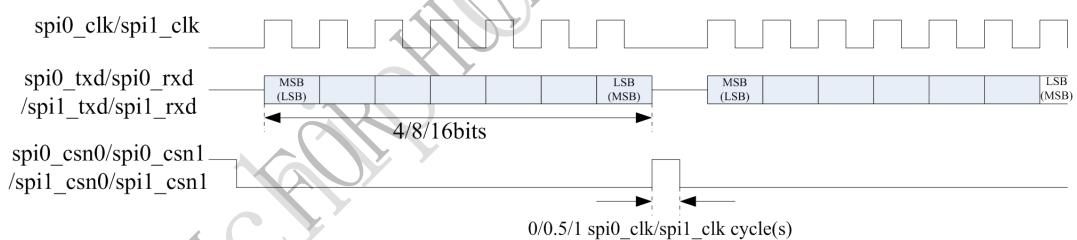


Fig. 34- 5SPI Format (SCPH=1 SCPOL=0)

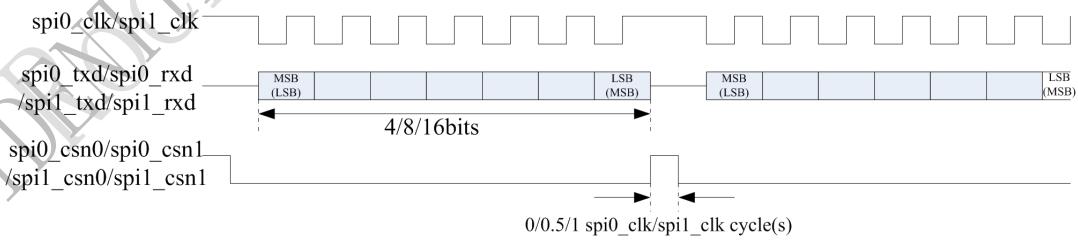


Fig. 34- 6SPI Format (SCPH=1 SCPOL=1)

34.4 Register description

This section describes the control/status registers of the design. Pay attention that there are two SPI controllers in the chip: spi0 & spi1, so the base address in the following register descriptions can be either spi0 or spi1 base address.

34.4.1 Registers Summary

Name	Offset	Size	Reset value	Description
SPI_CTRLR0	0x0000	W	0x2	Control Register 0
SPI_CTRLR1	0x0004	W	0x0	Control Register 1
SPI_ENR	0x0008	W	0x0	SPI Enable Register
SPI_SER	0x000C	W	0x0	Slave Enable Register
SPI_BAUDR	0x0010	W	0x0	Baud Rate Select
SPI_TXFTLR	0x0014	W	0x0	Transmit FIFO Threshold Level
SPI_RXFTLR	0x0018	W	0x0	Receive FIFO Threshold Level
SPI_TXFLR	0x001C	W	0x0	Transmit FIFO Level Register
SPI_RXFLR	0x0020	W	0x0	Receive FIFO Level Register
SPI_SR	0x0024	W	0xC	Status Register
SPI_IPR	0x0028	W	0x0	Interrupt Polarity Register
SPI_IMR	0x002C	W	0x0	Interrupt Mask Register
SPI_ISR	0x0030	W	0x0	Interrupt Status Register
SPI_RISR	0x0034	W	0x1	Raw Interrupt Status Register
SPI_ICR	0x0038	W	0x0	Interrupt Clear Register
SPI_DMACR	0x003C	W	0x0	DMA Control Register
SPI_DMATDLR	0x0040	W	0x0	DMA Transmit Data Level
SPI_DMARDLR	0x0044	W	0x0	DMA Receive Data Level
SPI_TXDR	0x0400~0x07FC	W	0x0	Transmit FIFO Data Register
SPI_RXDR	0x0800~0x0BFC	W	0x0	Receive FIFO Data Register

Notes:

Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

34.4.2 Detail Register Description

SPI_CTRLR0

Address: Operational Base + offset(0x00)

Control register 0

Bit	Attr	Reset Value	Description
31:22	-	-	Reserved.
21	RW	0x0	Microwire Transfer Mode. Valid when frame format is set to National Semiconductors Microwire. 0: non-sequential transfer 1: sequential transfer
20	RW	0X0	Operation Mode. 0 -- Master Mode 1 -- Slave Mode
19:18	RW	0X0	Transfer Mode. 00 :Transmit & Receive 01 : Transmit Only 10 : Receive Only 11 :reserved
17:16	RW	0X0	Frame Format. 00: Motorola SPI

			01: Texas Instruments SSP 10: National Semiconductors Microwire 11: Reserved
15:14	RW	0X0	Rxd Sample Delay. When SPI is configured as a master, if the rxd data cannot be sampled by the sclk_out edge at the right time, this register should be configured to define the number of the spi_clk cycles after the active sclk_out edge to sample rxd data later when SPI works at high frequency. 00:do not delay 01:1 cycle delay 10:2 cycles delay 11:3 cycles delay
13	RW	0X0	Byte and Halfword Transform Valid when data frame size is 8bit. 0:apb 16bit write/read, spi 8bit write/read 1: apb 8bit write/read, spi 8bit write/read
12	RW	0X0	First Bit Mode. 0:first bit is MSB 1:first bit is LSB
11	RW	0X0	Endian Mode Serial endian mode can be configured by this bit. Apb endian mode is always little endian. 0:little endian 1:big endian
10	RW	0X0	ss_n to sclk_out delay Valid when the frame format is set to Motorola SPI and SPI used as a master. 0: the period between ss_n active and sclk_out active is half sclk_out cycles. 1: the period between ss_n active and sclk_out active is one sclk_out cycle.
9:8	RW	0X0	Chip Select Mode. Valid when the frame format is set to Motorola SPI and SPI used as a master. 00: ss_n keep low after every frame data is transferred. 01:ss_n be high for half sclk_out cycles after every frame data is transferred. 10: ss_n be high for one sclk_out cycle after every frame data is transferred. 11:reserved
7	RW	0X0	Serial Clock Polarity. Valid when the frame format is set to Motorola SPI. 0 – Inactive state of serial clock is low 1 – Inactive state of serial clock is high
6	RW	0X0	Serial Clock Phase. Valid when the frame format is set to Motorola SPI. 0 –Serial clock toggles in middle of first data bit 1– Serial clock toggles at start of first data bit
5:2	RW	0X0	Control Frame Size. Selects the length of the control word for the Microwire

			frame format. 0000~0010:reserved 0011:4-bit serial data transfer 0100:5-bit serial data transfer 0101:6-bit serial data transfer 0110:7-bit serial data transfer 0111:8-bit serial data transfer 1000:9-bit serial data transfer 1001:10-bit serial data transfer 1010:11-bit serial data transfer 1011:12-bit serial data transfer 1100:13-bit serial data transfer 1101:14-bit serial data transfer 1110:15-bit serial data transfer 1111:16-bit serial data transfer
1:0	RW	0X2	Data Frame Size. Selects the data frame length. 00~4bit data 01~8bit data 10~16bit data 11~reserved

SPI_CTRLR1

Address: Operational Base + offset(0x04)

Control register 1

Bit	Attr	Reset Value	Description
31:16	-	-	Reserved.
15:0	RW	0x0	Number of Data Frames. When Transfer Mode is receive only, this register field sets the number of data frames to be continuously received by the SPI. The SPI continues to receive serial data until the number of data frames received is equal to this register value plus 1, which enables you to receive up to 64 KB of data in a continuous transfer.

SPI_ENR

Address: Operational Base + offset(0x08)

SPI enable register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved.
0	RW	0x0	SPI Enable. Enables and disables all SPI operations. Transmit and receive FIFO buffers are cleared when the device is disabled.

SPI_SER

Address: Operational Base + offset(0x0C)

Slave enable register

Bit	Attr	Reset Value	Description
31:2	-	-	Reserved.
1:0	RW	0x0	Slave Select Enable Flag. This register is valid only when SPI is configured as a master device.

SPI_BAUDR

Address: operational base + offset(0x10)

Baud rate select

Bit	Attr	Reset Value	Description
31:16	-	-	Reserved.
15:0	RW	0x0	<p>SPI Clock Divider. This register is valid only when the SPI is configured as a master device. The LSB for this field is always set to 0 and is unaffected by a write operation, which ensures an even value is held in this register.</p> <p>If the value is 0, the serial output clock (sclk_out) is disabled. The frequency of the sclk_out is derived from the following equation: $F_{sclk_out} = F_{spi_clk}/SCKDV$ Where SCKDV is any even value between 2 and 65534. For example: for $F_{spi_clk} = 3.6864\text{MHz}$ and $SCKDV = 2$ $F_{sclk_out} = 3.6864/2 = 1.8432\text{MHz}$</p>

SPI_TXFTLR

Address: Operational Base + offset(0x14)

Transmit FIFO Threshold Level

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4:0	RW	0x0	<p>Transmit FIFO Threshold. When the number of transmit FIFO entries is less than or equal to this value, the transmit FIFO empty interrupt is triggered.</p>

SPI_RXFTLR

Address: Operational Base + offset(0x18)

Receive FIFO Threshold Level

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4:0	RW	0x0	<p>Receive FIFO Threshold. When the number of receive FIFO entries is greater than or equal to this value + 1, the receive FIFO full interrupt is triggered.</p>

SPI_TXFLR

Address: Operational Base + offset(0x1C)

Transmit FIFO Level Register

Bit	Attr	Reset Value	Description
31:6	-	-	Reserved.
5:0	R	0x0	Transmit FIFO Level. Contains the number of valid data entries in the transmit FIFO.

SPI_RXFLR

Address: Operational Base + offset(0x20)

Receive FIFO Level Register

Bit	Attr	Reset Value	Description

31:6	-	-	Reserved.
5:0	R	0x0	Receive FIFO Level. Contains the number of valid data entries in the receive FIFO.

SPI_SR

Address: Operational Base + offset(0x24)

Status Register

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4	R	0x0	Receive FIFO Full. 0 – Receive FIFO is not full 1 – Receive FIFO is full
3	R	0x1	Receive FIFO Empty. 0 – Receive FIFO is not empty 1 – Receive FIFO is empty
2	R	0x1	Transmit FIFO Empty. 0 – Transmit FIFO is not empty 1 – Transmit FIFO is empty
1	R	0x0	Transmit FIFO Full. 0 – Transmit FIFO is not full 1 – Transmit FIFO is full
0	R	0x0	SPI Busy Flag. When set, indicates that a serial transfer is in progress; when cleared indicates that the SPI is idle or disabled. 0 – SPI is idle or disabled 1 – SPI is actively transferring data

SPI_IPR

Address: Operational Base + offset(0x28)

Interrupt Polarity Register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved.
0	RW	0x0	Interrupt Polarity Register 0: Active Interrupt Polarity Level is HIGH 1: Active Interrupt Polarity Level is LOW

SPI_IMR

Address: Operational Base + offset(0x2C)

Interrupt Mask Register

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4	RW	0x0	Receive FIFO Full Interrupt Mask 0 – spi_rxf_intr interrupt is masked 1 – spi_rxf_intr interrupt is not masked
3	RW	0x0	Receive FIFO Overflow Interrupt Mask 0 – spi_rxo_intr interrupt is masked 1 – spi_rxo_intr interrupt is not masked
2	RW	0x0	Receive FIFO Underflow Interrupt Mask 0 – spi_rxu_intr interrupt is masked 1 – spi_rxu_intr interrupt is not masked
1	RW	0x0	Transmit FIFO Overflow Interrupt Mask 0 – spi_txo_intr interrupt is masked

			1 – spi_txo_intr interrupt is not masked
0	RW	0x0	Transmit FIFO Empty Interrupt Mask 0 – spi_txe_intr interrupt is masked 1 – spi_txe_intr interrupt is not masked

SPI_ISR

Address: Operational Base + offset(0x30)

Interrupt Status Register

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4	R	0x0	Receive FIFO Full Interrupt Status 0 = spi_rxf_intr interrupt is not active after masking 1 = spi_rxf_intr interrupt is full after masking
3	R	0x0	Receive FIFO Overflow Interrupt Status 0 = spi_rxo_intr interrupt is not active after masking 1 = spi_rxo_intr interrupt is active after masking
2	R	0x0	Receive FIFO Underflow Interrupt Status 0 = spi_rxu_intr interrupt is not active after masking 1 = spi_rxu_intr interrupt is active after masking
1	R	0x0	Transmit FIFO Overflow Interrupt Status 0 = spi_txo_intr interrupt is not active after masking 1 = spi_txo_intr interrupt is active after masking
0	R	0x0	Transmit FIFO Empty Interrupt Status 0 = spi_txe_intr interrupt is not active after masking 1 = spi_txe_intr interrupt is active after masking

SPI_RISR

Address: Operational Base + offset(0x34)

Raw Interrupt Status Register

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4	R	0x0	Receive FIFO Full Raw Interrupt Status 0 = spi_rxf_intr interrupt is not active prior to masking 1 = spi_rxf_intr interrupt is full prior to masking
3	R	0x0	Receive FIFO Overflow Raw Interrupt Status 0 = spi_rxo_intr interrupt is not active prior to masking 1 = spi_rxo_intr interrupt is active prior to masking
2	R	0x0	Receive FIFO Underflow Raw Interrupt Status 0 = spi_rxu_intr interrupt is not active prior to masking 1 = spi_rxu_intr interrupt is active prior to masking
1	R	0x0	Transmit FIFO Overflow Raw Interrupt Status 0 = spi_txo_intr interrupt is not active prior to masking 1 = spi_txo_intr interrupt is active prior to masking
0	R	0x1	Transmit FIFO Empty Raw Interrupt Status 0 = spi_txe_intr interrupt is not active prior to masking 1 = spi_txe_intr interrupt is active prior to masking

SPI_ICR

Address: Operational Base + offset(0x38)

Interrupt Clear Register

Bit	Attr	Reset Value	Description
-----	------	-------------	-------------

31:4	-	-	Reserved.
3	W	0x0	Clear Transmit FIFO Overflow Interrupt.
2	W	0x0	Clear Receive FIFO Overflow Interrupt.
1	W	0x0	Clear Receive FIFO Underflow Interrupt.
0	W	0x0	Clear Combined Interrupt.

SPI_DMACR

Address: Operational Base + offset(0x3C)

DMA Control Register

Bit	Attr	Reset Value	Description
31:2	-	-	Reserved.
1	RW	0x0	Transmit DMA Enable. 0 = Transmit DMA disabled 1 = Transmit DMA enabled
0	RW	0x0	Receive DMA Enable. 0 = Receive DMA disabled 1 = Receive DMA enabled

SPI_DMATDLR

Address: Operational Base + offset(0x40)

DMA Transmit Data Level

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4:0	RW	0x0	Transmit Data Level. This bit field controls the level at which a DMA request is made by the transmit logic. It is equal to the watermark level; that is, the dma_tx_req signal is generated when the number of valid data entries in the transmit FIFO is equal to or below this field value, and Transmit DMA Enable (DMACR[1]) = 1.

SPI_DMARDLR

Address: Operational Base + offset(0x44)

DMA Receive Data Level

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved.
4:0	RW	0x0	Receive Data Level. This bit field controls the level at which a DMA request is made by the receive logic. The watermark level = DMARDL+1; that is, dma_rx_req is generated when the number of valid data entries in the receive FIFO is equal to or above this field value + 1, and Receive DMA Enable(DMACR[0])=1.

SPI_TXDR

Address: Operational Base + offset(0x400~0x7FC)

Transimt FIFO Data Register

Bit	Attr	Reset Value	Description
31:16	-	-	Reserved.
15:0	W	0x0	Transimt FIFO Data Register. When it is written to, data are moved into the transmit FIFO.

SPI_RXDR

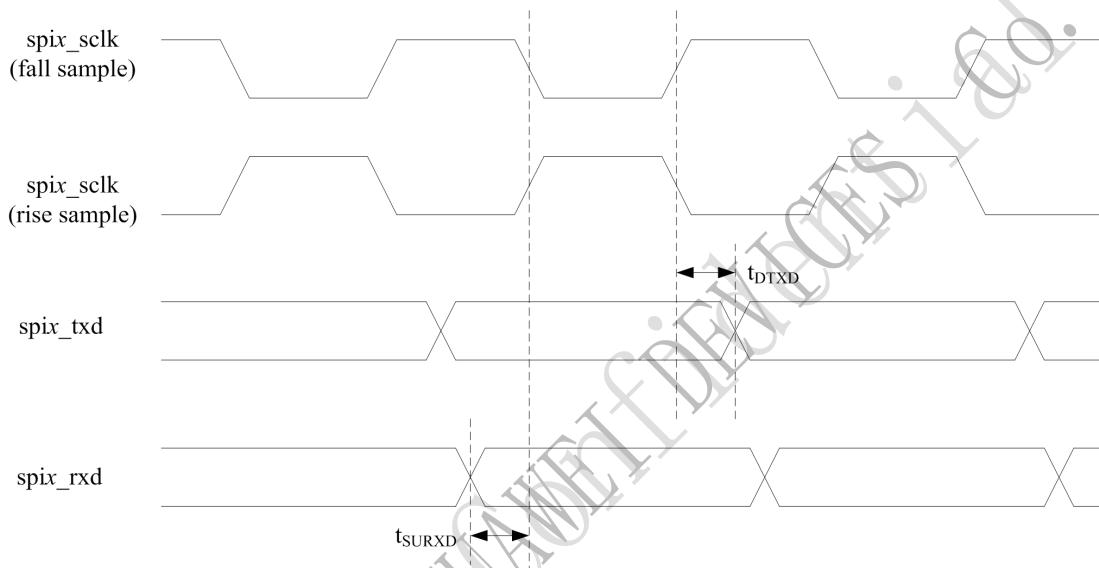
Address: Operational Base + offset(0x800~0xBFC)

Receive FIFO Data Register

Bit	Attr	Reset Value	Description
31:16	-	-	Reserved.
15:0	R	0x0	Receive FIFO Data Register. When theregister is read, data in the receive FIFO is accessed.

Notes: Attr: **RW**- Read/writable, **R**- read only, **W**- write only

34.5 Timing Diagram



Note: $x=0,1$

Fig. 34-7 SPI controller timing diagram

Table 34-1 Meaning of the parameter in Fig.35-7

Parameter	Description	min	typ	max	unit
t_{DTXD}	spix_txd propagation delay from spix_sclk drive edge	1.512	2.500	3.893	ns
t_{SURXD}	spix_rxd setup time to spix_sclk sample edge	3.845	5.403	7.551	ns

Note: $x=0$

Parameter	Description	min	typ	max	unit
t_{DTXD}	spix_txd propagation delay from spix_sclk drive edge	4.581	5.471	6.908	ns
t_{SURXD}	spix_rxd setup time to spix_sclk sample edge	4.227	5.788	8.137	ns

Note: $x=1$

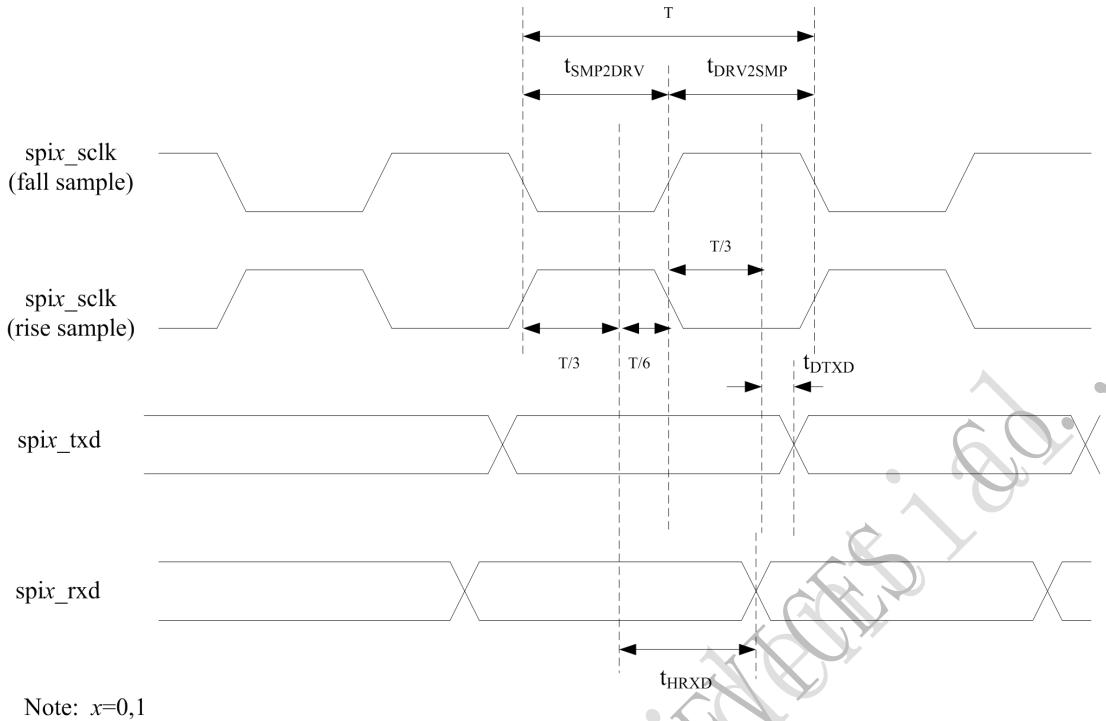


Fig. 34- 8SPI controller timing diagram in slave mode

Table 34- 2 Meaning of the parameter in Fig.35-8

Parameter	Description	min	typ	max	unit
T	spix_sclk cycle time (cannot be less than 60 ns)	-	-	-	ns
t _{SMP2DRV}	spix_sclk pulse width from sample edge to drive edge (cannot be less than 30 ns)	-	-	-	ns
t _{DRV2SMP}	spix_sclk pulse width from drive edge to sample edge (cannot be less than 30 ns)	-	-	-	ns
t _{DTXD}	spix_txd propagation delay from T/3 after spix_sclk drive edge	6.771	10.146	14.691	ns
t _{HRXD}	spix_rxd hold time from T/3 after spix_sclk sample edge	0.238	0.489	0.676	ns

Note: $x=0,1$

34.6 Interface description

Table 34- 3SPI interface description in master mode

Module Pin	Direction	Pad Name	IOMUX Setting
spi0_clk	I/O	GPIO1_A[6]	GRF_GPIO1A_IOMUX[13:12]=10
spi0_csn0	I/O	GPIO1_A[7]	GRF_GPIO1A_IOMUX[15:14]=10
spi0_txd	O	GPIO1_A[5]	GRF_GPIO1A_IOMUX[11:10]=10
spi0_rxd	I	GPIO1_A[4]	GRF_GPIO1A_IOMUX[9:8]=10
spi1_clk	I/O	GPIO0_D[6]	GRF_GPIO0D_IOMUX[12]=1
spi1_csn0	I/O	GPIO0_D[7]	GRF_GPIO0D_IOMUX[14]=1
spi1_txd	O	GPIO0_D[5]	GRF_GPIO0D_IOMUX[10]=1
spi1_rxd	I	GPIO0_D[4]	GRF_GPIO0D_IOMUX[8]=1
spi1_csn1	O	GPIO1_B[6]	GRF_GPIO1B_IOMUX[13:12]=10
spi0_csn1	O	GPIO1_B[7]	GRF_GPIO1B_IOMUX[14]=1

Note: spi0_csn1, spi1_csn1 can only be used in master mode

Table 34- 4SPI interface description in slave mode

Module Pin	Direction	Pad Name	IOMUX Setting
spi0_clk	I/O	GPIO1_A[6]	GRF_GPIO1A_IOMUX[13:12]=10
spi0_csn0	I/O	GPIO1_A[7]	GRF_GPIO1A_IOMUX[15:14]=10
spi0_txd	O	GPIO1_A[5]	GRF_GPIO1A_IOMUX[11:10]=10
spi0_rxd	I	GPIO1_A[4]	GRF_GPIO1A_IOMUX[9:8]=10
spi1_clk	I/O	GPIO0_D[6]	GRF_GPIO0D_IOMUX[12]=1
spi1_csn0	I/O	GPIO0_D[7]	GRF_GPIO0D_IOMUX[14]=1
spi1_txd	O	GPIO0_D[5]	GRF_GPIO0D_IOMUX[10]=1
spi1_rxd	I	GPIO0_D[4]	GRF_GPIO0D_IOMUX[8]=1

34.7 Application Notes

● Clock Ratios

A summary of the frequency ratio restrictions between the bit-rate clock (sclk_out/sclk_in) and the SPI peripheral clock (spi_clk) are described as:

Master: $F_{\text{spi_clk}} \geq 2 \times (\text{maximum } F_{\text{sclk_out}})$

Slave: $F_{\text{spi_clk}} \geq 6 \times (\text{maximum } F_{\text{sclk_in}})$

● Master Transfer Flow

When configured as a serial-master device, the SPI initiates and controls all serial transfers. The serial bit-rate clock, generated and controlled by the SPI, is driven out on the sclk_out line. When the SPI is disabled (SPI_ENR = 0), no serial transfers can occur and sclk_out is held in "inactive" state, as defined by the serial protocol under which it operates.

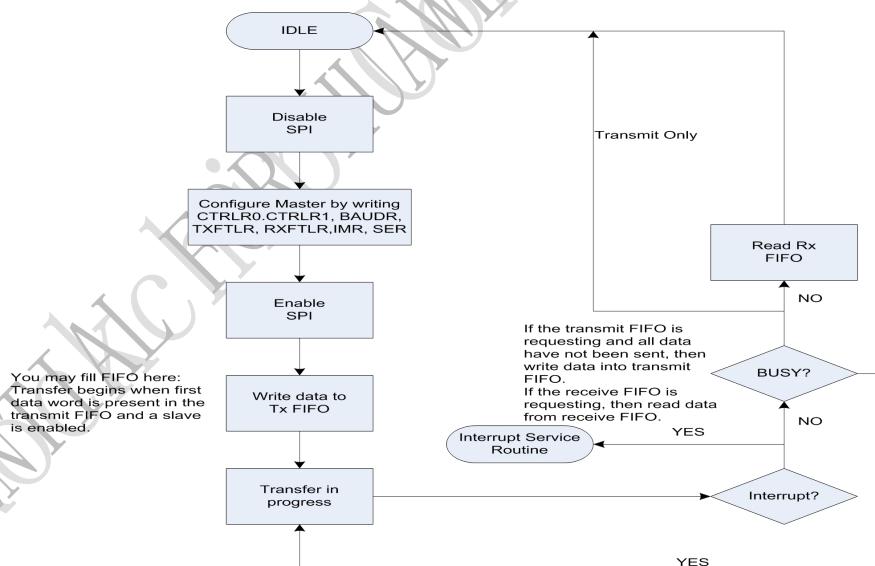


Fig. 34- 9SPI Master transfer flow diagram

● Slave Transfer Flow

When the SPI is configured as a slave device, all serial transfers are initiated and controlled by the serial bus master.

When the SPI serial slave is selected during configuration, it enables its txd data onto the serial bus. All data transfers to and from the serial slave are regulated on the serial clock line (sclk_in), driven from the serial-master device. Data are propagated from the serial slave on one edge of the serial clock line and sampled on the opposite edge.

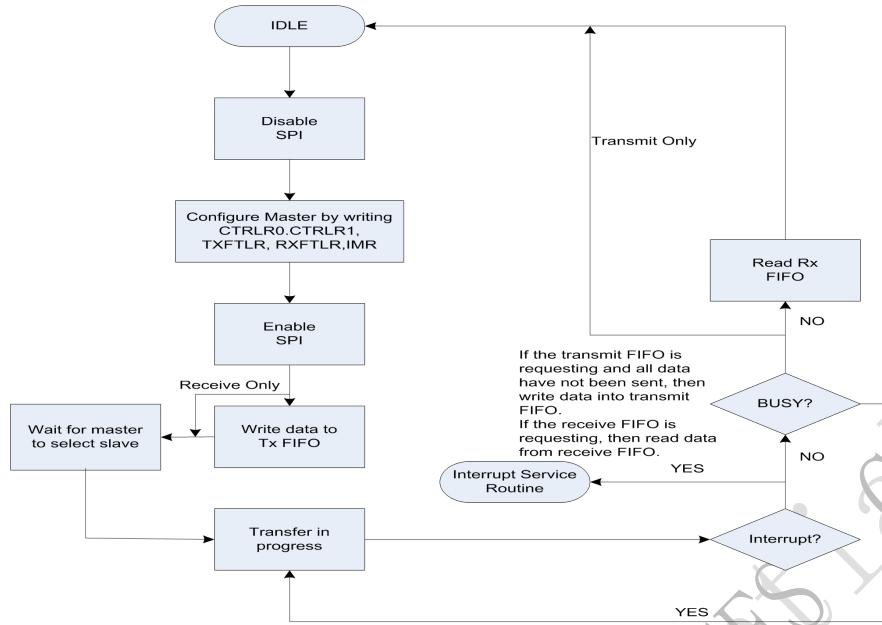


Fig. 34- 10SPI Slave transfer flow diagram

Chapter 35 UART Interface

35.1 Overview

The Universal Asynchronous Receiver/Transmitter (UART) is used for serial communication with a peripheral, modem (data carrier equipment, DCE) or data set. Data is written from a master (CPU) over the APB bus to the UART and it is converted to serial form and transmitted to the destination device. Serial data is also received by the UART and stored for the master (CPU) to read back.

35.1.1 Features

- AMBA APB interface – Allows for easy integration into a Synthesizable Components for AMBA 2 implementation.
- Support interrupt interface to interrupt controller.
- UART1/UART2/UART3 contain two 32Bytes FIFOs for data receive and transmit, UART0's two embedded FIFOs are both 64Bytes for BT transfer.
- Programmable serial data baud rate as calculated by the following: baud rate = (serial clock frequency)/(16×divisor).
- UART0 / UART1 / UART3 support auto flow-control, UART2 do not support auto flow-control.
- UART0 is in cpu system, UART1 is in alive system, UART2 / UART3 are in peri system.

35.2 Block Diagram

This section provides a description about the functions and behavior under various conditions.

The UART comprises with:

- AMBA APB interface
- FIFO controllers
- Register block
- Modem synchronization block and baud clock generation block
- Serial receiver and serial transmitter

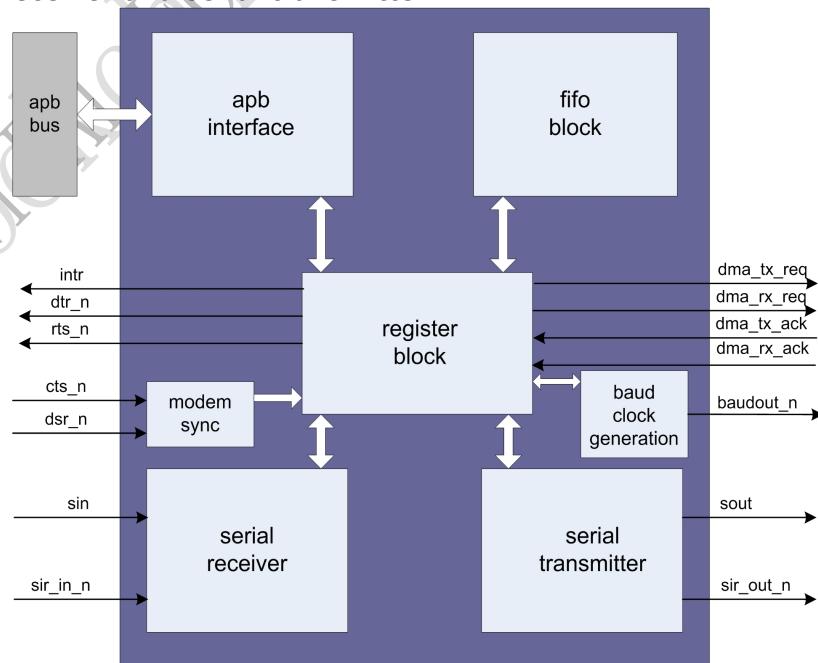


Fig. 35-1 UART Architecture

APB INTERFACE

The host processor accesses data, control, and status information on the UART through the APB interface. The UART supports APB data bus widths of 8, 16, and 32 bits.

Register block

Be responsible for the main UART functionality including control, status and interrupt generation.

Modem Synchronization block

Synchronizes the modem input signal.

FIFO block

Be responsible for FIFO control and storage (when using internal RAM) or signaling to control external RAM (when used).

Baud Clock Generator

Produces the transmitter and receiver baud clock along with the output reference clock signal (baudout_n).

Serial Transmitter

Converts the parallel data, written to the UART, into serial form and adds all additional bits, as specified by the control register, for transmission. This makeup of serial data, referred to as a character can exit the block in two forms, either serial UART format or IrDA 1.0 SIR format.

Serial Receiver

Converts the serial data character (as specified by the control register) received in either the UART or IrDA 1.0 SIR format to parallel form. Parity error detection, framing error detection and line break detection is carried out in this block.

35.3 Function description

- UART (RS232) Serial Protocol

Because the serial communication is asynchronous, additional bits (start and stop) are added to the serial data to indicate the beginning and end. An additional parity bit may be added to the serial character. This bit appears after the last data bit and before the stop bit(s) in the character structure to perform simple error checking on the received data, as shown in Figure.

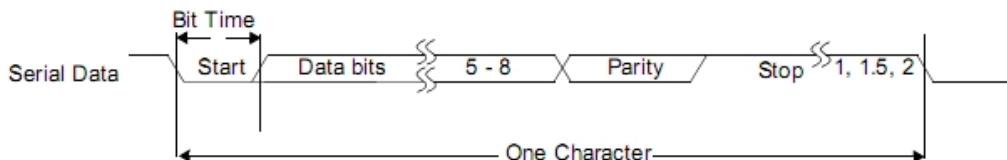


Fig. 35-2 UART Serial protocol

- Baud Clock

The baud rate controlled by the serial clock (sclk or pclk in a single clock implementation) and the Divisor Latch Register (DLH and DLL). As the exact number of baud clocks that each bit was transmitted for is known, calculating the mid point for sampling is not difficult, that is every 16 baud clocks after the

mid point sample of the start bit.

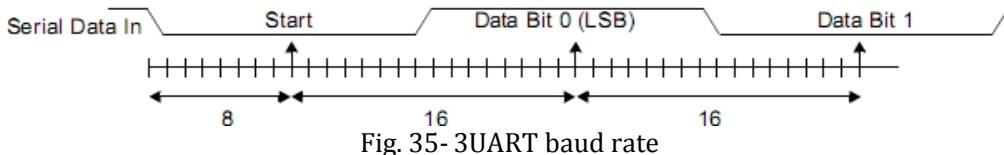


Fig. 35-3UART baud rate

- FIFO Support
 - 1.NONE FIFO MODE

If FIFO support is not selected, then no FIFOs are implemented and only a single receive data byte and transmit data byte can be stored at a time in the RBR and THR.

- 2.FIFO MODE

The FIFO depth is 32, enabled by register FCR[0].

- Interrupts

The following interrupt types can be enabled with the IER register.

Receiver Error;

Receiver Data Available;

Character Timeout (in FIFO mode only);

Transmitter Holding Register Empty at/below threshold (in Programmable THRE Interrupt mode);

Modem Status;

- DMA Support

The uart supports DMA signaling with the use of two output signals (dma_tx_req_n and dma_rx_req_n) to indicate when data is ready to be read or when the transmit FIFO is empty.

The dma_tx_req_n signal is asserted under the following conditions:

- a) When the Transmitter Holding Register is empty in non-FIFO mode.
- b) When the transmitter FIFO is empty in FIFO mode with Programmable THRE interrupt mode disabled.
- c) When the transmitter FIFO is at, or below the programmed threshold with Programmable THRE interrupt mode enabled.

The dma_rx_req_n signal is asserted under the following conditions:

- a) When there is a single character available in the Receive Buffer Register in non-FIFO mode.
- b) When the Receiver FIFO is at or above the programmed trigger level in FIFO mode.

- Auto Flow Control

The uart can be configured to have a 16750-compatible Auto RTS and Auto CTS serial data flow control mode available. If FIFOs are not implemented, then this mode cannot be selected. When Auto Flow Control mode has been selected it can be enabled with the Modem Control Register (MCR[5]). Following figure shows a block diagram of the Auto Flow Control functionality.

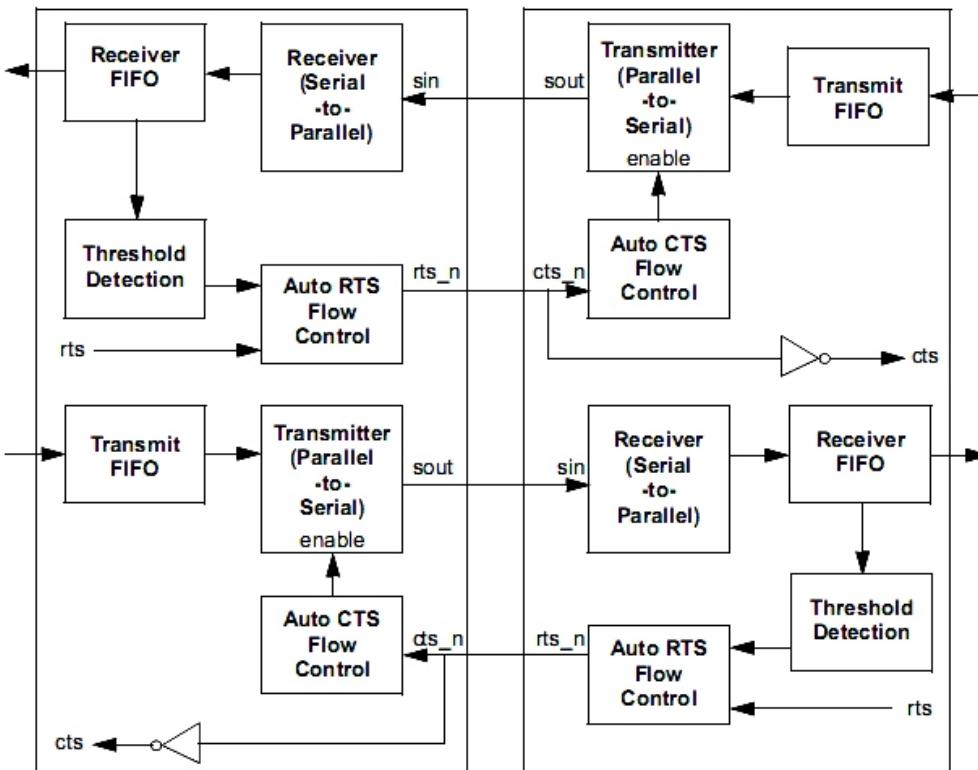


Fig. 35- 4UART Auto flow control block diagram

Auto RTS – Becomes active when the following occurs:

- Auto Flow Control is selected during configuration
- FIFOs are implemented
- RTS (MCR[1] bit and MCR[5]bit are both set)
- FIFOs are enabled (FCR[0]) bit is set)
- SIR mode is disabled (MCR[6] bit is not set)

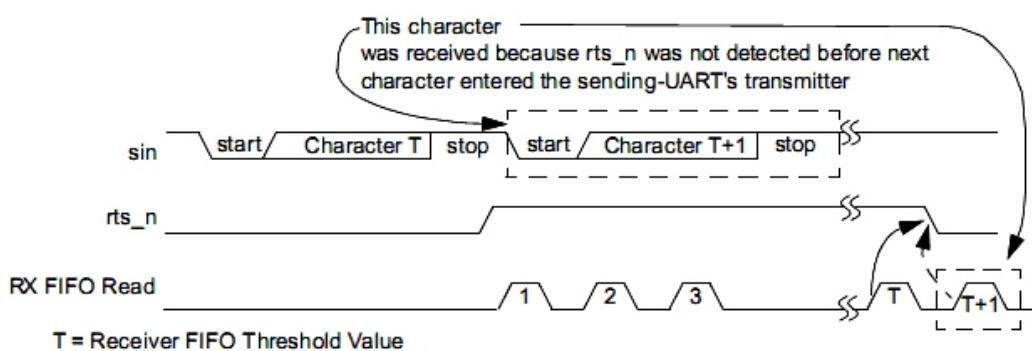


Fig. 35- 5UART AUTO RTS TIMING

Auto CTS – becomes active when the following occurs:

- Auto Flow Control is selected during configuration
- FIFOs are implemented
- AFCE (MCR[5] bit is set)
- FIFOs are enabled through FIFO Control Register FCR[0] bit
- SIR mode is disabled (MCR[6] bit is not set)

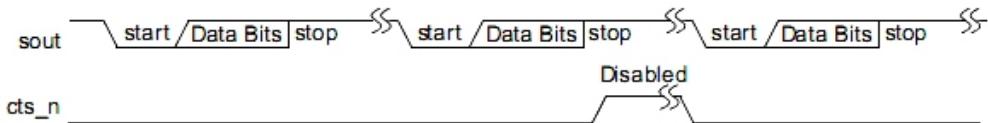


Fig. 35-6 UART AUTO CTS TIMING

35.4 Register description

There are 4 UARTs in RK3168, and each one has its own base address.

35.4.1 Registers Summary

Name	Offset	Size	Reset Value	Description
UART_RBR	0x0000	W	0x0000_0000	Receive Buffer Register
UART_THR				Transmit Holding Register
UART_DLL				Divisor Latch (Low)
UART_DLH	0x0004	W	0x0000_0000	Divisor Latch (High)
UART_IER				Interrupt Enable Register
UART_IIR	0x0008	W	0x0000_0000	Interrupt Identification Register
UART_FCR				FIFO Control Register
UART_LCR	0x000C	W	0x0000_0000	Line Control Register
UART_MCR	0x0010	W	0x0000_0000	Modem Control Register
UART_LSR	0x0014	W	0x0000_0060	Line Status Register
UART_MSR	0x0018	W	0x0000_0000	Modem Status Register
UART_SCR	0x001c	W	0x0000_0000	Scratchpad Register
Reserved	0x0020 -2C	W	0x0000_0000	--
UART_SRBR	0x0030	W	0x0000_0000	Shadow Receive Buffer Register
UART_STHR	-6C	W	0x0000_0000	Shadow Transmit Holding Register
UART_FAR	0x0070	W	0x0000_0000	FIFO Access Register
UART_TFR	0x0074	W	0x0000_0000	Transmit FIFO Read
UART_RFW	0x0078	W	0x0000_0000	Receive FIFO Write
UART_USR	0x007C	W	0x0000_0006	UART Status Register
UART_TFL	0x0080	W	0x0000_0000	Transmit FIFO Level
UART_RFL	0x0084	W	0x0000_0000	Receive FIFO Level
UART_SRR	0x0088	W	0x0000_0000	Software Reset Register
UART_SRTS	0x008C	W	0x0000_0000	Shadow Request to Send
UART_SBCR	0x0090	W	0x0000_0000	Shadow Break Control Register
UART_SDMAM	0x0094	W	0x0000_0000	Shadow DMA Mode
UART_SFE	0x0098	W	0x0000_0000	Shadow FIFO Enable
UART_SRT	0x009C	W	0x0000_0000	Shadow RCVR Trigger
UART_STET	0x00A0	W	0x0000_0000	Shadow TX Empty Trigger
UART_HTX	0x00A4	W	0x0000_0000	Halt TX
UART_DMASA	0x00A8	W	0x0000_0000	DMA Software Acknowledge
Reserved	0x00AC -F0	W	0x0000_0000	--
UART_CPR	0x00F4	W	0x0000_0000	Component Parameter Register
UART_UCV	0x00F8	W	0x3330_372a	UART Component Version
UART_CTR	0x00FC	W	0x4457_0110	Component Type Register

Notes:

Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

35.4.2 Registers detail description

UART_RBR

Address: Operational Base + offset(0x00)

Receive Buffer Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	Data byte received on the serial input port (sin) in UART mode, or the serial infrared input (sir_in) in infrared mode. The data in this register is valid only if the Data Ready (DR) bit in the Line Status Register (LSR) is set. If in non-FIFO mode (FIFO_MODE == NONE) or FIFOs are disabled (FCR[0] set to zero), the data in the RBR must be read before the next data arrives, otherwise it is overwritten, resulting in an over-run error. If in FIFO mode (FIFO_MODE != NONE) and FIFOs are enabled (FCR[0] set to one), this register accesses the head of the receive FIFO. If the receive FIFO is full and this register is not read before the next data character arrives, then the data already in the FIFO is preserved, but any incoming data are lost and an over-run error occurs.

UART_THR

Address: Operational Base + offset(0x00)

Transmit Holding Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	Data to be transmitted on the serial output port (sout) in UART mode or the serial infrared output (sir_out_n) in infrared mode. Data should only be written to the THR when the THR Empty (THRE) bit (LSR[5]) is set. If in non-FIFO mode or FIFOs are disabled (FCR[0] = 0) and THRE is set, writing a single character to the THR clears the THRE. Any additional writes to the THR before the THRE is set again causes the THR data to be overwritten. If in FIFO mode and FIFOs are enabled (FCR[0] = 1) and THRE is set, x number of characters of data may be written to the THR before the FIFO is full. The number x (default=16) is determined by the value of FIFO Depth that you set during configuration. Any attempt to write data when the FIFO is full results in the write data being lost.

UART_DLL

Address: Operational Base + offset(0x00)

Divisor Latch (Low)

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	Lower 8-bits of a 16-bit, read/write, Divisor Latch

			<p>register that contains the baud rate divisor for the UART. This register may only be accessed when the DLAB bit (LCR[7]) is set and the UART is not busy (USR[0] is zero).</p> <p>The output baud rate is equal to the serial clock (sclk) frequency divided by sixteen times the value of the baud rate divisor, as follows: baud rate = (serial clock freq) / (16 * divisor).</p> <p>Note that with the Divisor Latch Registers (DLL and DLH) set to zero, the baud clock is disabled and no serial communications occur. Also, once the DLH is set, at least 8 clock cycles of the slowest Uart clock should be allowed to pass before transmitting or receiving data.</p>
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UART_DLH

Address: Operational Base + offset(0x04)

Divisor Latch (High)

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	Upper 8 bits of a 16-bit, read/write, Divisor Latch register that contains the baud rate divisor for the UART.

UART_IER

Address: Operational Base + offset(0x04)

Interrupt Enable Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7	RW	0x0	Programmable THRE Interrupt Mode Enable This is used to enable/disable the generation of THRE Interrupt. 0 = disabled 1 = enabled
6:4	-	-	Reserved
3	RW	0X0	Enable Modem Status Interrupt. This is used to enable/disable the generation of Modem Status Interrupt. This is the fourth highest priority interrupt. 0 = disabled 1 = enabled
2	RW	0X0	Enable Receiver Line Status Interrupt. This is used to enable/disable the generation of Receiver Line Status Interrupt. This is the highest priority interrupt. 0 = disabled 1 = enabled
1	RW	0X0	Enable Transmit Holding Register Empty Interrupt. This is used to enable/disable the generation of Transmitter Holding Register Empty Interrupt. This is the third highest priority interrupt. 0 = disabled 1 = enabled
0	RW	0X0	Enable Received Data Available Interrupt. This is used to enable/disable the generation of Received Data

			Available Interrupt and the Character Timeout Interrupt (if in FIFO mode and FIFOs enabled). These are the second highest priority interrupts. 0 = disabled 1 = enabled
--	--	--	---

UART_IIR

Address: Operational Base + offset(0x08)

Interrupt Identification Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:6	R	0x01	FIFOs Enabled. This is used to indicate whether the FIFOs are enabled or disabled. 00 = disabled 11 = enabled
5:4	-	-	Reserved
3:0	R	0x01	Interrupt ID. This indicates the highest priority pending interrupt which can be one of the following types: 0000 = modem status 0001 = no interrupt pending 0010 = THR empty 0100 = received data available 0110 = receiver line status 0111 = busy detect 1100 = character timeout

UART_FCR

Address: Operational Base + offset(0x08)

FIFO Control Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:6	W	0x0	RCVR Trigger. This is used to select the trigger level in the receiver FIFO at which the Received Data Available Interrupt is generated. In auto flow control mode it is used to determine when the rts_n signal is de-asserted. It also determines when the dma_rx_req_n signal is asserted in certain modes of operation. The following trigger levels are supported: 00 = 1 character in the FIFO 01 = FIFO 1/4 full 10 = FIFO 1/2 full 11 = FIFO 2 less than full
5:4	W	0x0	TX Empty Trigger. This is used to select the empty threshold level at which the THRE Interrupts are generated when the mode is active. It also determines when the dma_tx_req_n signal is asserted when in certain modes of operation. The following trigger levels are supported: 00 = FIFO empty 01 = 2 characters in the FIFO

			10 = FIFO 1/4 full 11 = FIFO 1/2 full
3	W	0x0	DMA Mode. This determines the DMA signalling mode used for the dma_tx_req_n and dma_rx_req_n output signals when additional DMA handshaking signals are not selected . 0 = mode 0 1 = mode 11100 = character timeout
2	W	0x0	XMIT FIFO Reset. This resets the control portion of the transmit FIFO and treats the FIFO as empty. This also de-asserts the DMA TX request and single signals when additional DMA handshaking signals are selected . Note that this bit is 'self-clearing'. It is not necessary to clear this bit.
1	W	0x0	RCVR FIFO Reset. This resets the control portion of the receive FIFO and treats the FIFO as empty. This also de-asserts the DMA RX request and single signals when additional DMA handshaking signals are selected . Note that this bit is 'self-clearing'. It is not necessary to clear this bit
0	W	0x0	FIFO Enable. This enables/disables the transmit (XMIT) and receive (RCVR) FIFOs. Whenever the value of this bit is changed both the XMIT and RCVR controller portion of FIFOs is reset.

UART_LCR

Address: Operational Base + offset(0x0C)

Line Control Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7	RW	0x0	Divisor Latch Access Bit. Writeable only when UART is not busy (USR[0] is zero), always readable. This bit is used to enable reading and writing of the Divisor Latch register (DLL and DLH) to set the baud rate of the UART. This bit must be cleared after initial baud rate setup in order to access other registers
6	RW	0x0	Break Control Bit. This is used to cause a break condition to be transmitted to the receiving device. If set to one the serial output is forced to the spacing (logic 0) state. When not in Loopback Mode, as determined by MCR[4], the sout line is forced low until the Break bit is cleared. If MCR[6] set to one, the sir_out_n line is continuously pulsed. When in Loopback Mode, the break condition is internally looped back to thereceiver and the sir_out_n line is forced low
5	-	-	Reserved
4	RW	0x0	Even Parity Select. Writeable only when UART is not busy (USR[0] is zero), always readable. This is used to select between even and odd parity, when parity is enabled (PEN set to one). If set to one, an even number of logic 1s is transmitted or checked. If set to zero, an odd number of logic 1s is transmitted or

			checked.
3	RW	0x0	Parity Enable. Writeable only when UART is not busy (USR[0] is zero), always readable. This bit is used to enable and disable parity generation and detection in transmitted and received serial character respectively. 0 = parity disabled 1 = parity enabled
2	RW	0x0	Number of stop bits. Writeable only when UART is not busy (USR[0] is zero), always readable. This is used to select the number of stop bits per character that the peripheral transmits and receives. If set to zero, one stop bit is transmitted in the serial data. If set to one and the data bits are set to 5 (LCR[1:0] set to zero) one and a half stop bits are transmitted. Otherwise, two stop bits are transmitted. Note that regardless of the number of stop bits selected, the receiver checks only the first stop bit. 0 = 1 stop bit 1 = 1.5 stop bits when DLS (LCR[1:0]) is zero, else 2 stop bit
1:0	RW	0x0	Data Length Select. Writeable only when UART is not busy (USR[0] is zero), always readable. This is used to select the number of data bits per character that the peripheral transmits and receives. The number of bits that may be selected areas follows: 00 = 5 bits 01 = 6 bits 10 = 7 bits 11 = 8 bits

UART_MCR

Address: Operational Base + offset(0x10)

Modem Control Register

Bit	Attr	Reset Value	Description
31:7	-	-	Reserved
6	RW	0x0	SIR Mode Enable. This is used to enable/disable the IrDA SIR Mode . 0 = IrDA SIR Mode disabled 1 = IrDA SIR Mode enabled
5	RW	0x0	Auto Flow Control Enable. 0 = Auto Flow Control Mode disabled 1 = Auto Flow Control Mode enabled
4	RW	0x0	LoopBack Bit. This is used to put the UART into a diagnostic mode for test purposes.
3	RW	0x0	OUT2. This is used to directly control the user-designated Output2 (out2_n) output. The value written to this location is inverted and driven out on out2_n, that is: 0 = out2_n de-asserted (logic 1) 1 = out2_n asserted (logic 0)
2	RW	0x0	OUT1

1	RW	0x0	Request to Send. This is used to directly control the Request to Send (rts_n) output. The Request To Send (rts_n) output is used to inform the modem or data set that the UART is ready to exchange data
0	RW	0x0	Data Terminal Ready. This is used to directly control the Data Terminal Ready (dtr_n) output. The value written to this location is inverted and driven out on dtr_n, that is: 0 = dtr_n de-asserted (logic 1) 1 = dtr_n asserted (logic 0)

UART_LSR

Address: Operational Base + offset(0x14)

Line Status Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7	R	0x0	Receiver FIFO Error bit. This bit is relevant FIFOs are enabled (FCR[0] set to one). This is used to indicate if there is at least one parity error, framing error, or break indication in the FIFO. 0 = no error in RX FIFO 1 = error in RX FIFO
6	R	0x1	Transmitter Empty bit. If FIFOs enabled (FCR[0] set to one), this bit is set whenever the Transmitter Shift Register and the FIFO are both empty. If FIFOs are disabled, this bit is set whenever the Transmitter Holding Register and the Transmitter Shift Register are both empty.
5	R	0x1	Transmit Holding Register Empty bit. If THRE mode is disabled (IER[7] set to zero) and regardless of FIFO's being implemented/enabled or not, this bit indicates that the THR or TX FIFO is empty. This bit is set whenever data is transferred from the THR or TX FIFO to the transmitter shift register and no new data has been written to the THR or TX FIFO. This also causes a THRE Interrupt to occur, if the THRE Interrupt is enabled. If IER[7] set to one and FCR[0] set to one respectively, the functionality is switched to indicate the transmitter FIFO is full, and no longer controls THRE interrupts, which are then controlled by the FCR[5:4] threshold setting.
4	R	0x0	Break Interrupt bit. This is used to indicate the detection of a break sequence on the serial input data.
3	R	0x0	Framing Error bit. This is used to indicate the occurrence of a framing error in the receiver. A framing error occurs when the receiver does not detect a valid STOP bit in the received data.
2		0x0	Parity Error bit. This is used to indicate the occurrence of a parity error in the receiver if the Parity Enable (PEN) bit (LCR[3]) is set.
1	R	0x0	Overrun error bit. This is used to indicate the occurrence of an overrun error. This occurs if a new

			data character was received before the previous data was read.
0	R	0x0	Data Ready bit. This is used to indicate that the receiver contains at least one character in the RBR or the receiver FIFO. 0 = no data ready 1 = data ready

UART_MSR

Address: Operational Base + offset(0x18)

Modem Status Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7	R	0x0	Data Carrier Detect. This is used to indicate the current state of the modem control line dcd_n.
6	R	0x0	Ring Indicator. This is used to indicate the current state of the modem control line ri_n.
5	R	0x0	Data Set Ready. This is used to indicate the current state of the modem control line dsr_n.
4	R	0x0	Clear to Send. This is used to indicate the current state of the modem control line cts_n.
3	R	0x0	Delta Data Carrier Detect. This is used to indicate that the modem control line dcd_n has changed since the last time the MSR was read.
2	R	0x0	Trailing Edge of Ring Indicator. This is used to indicate that a change on the input ri_n (from an active-low to an inactive-high state) has occurred since the last time the MSR was read.
1	R	0x0	Delta Data Set Ready. This is used to indicate that the modem control line dsr_n has changed since the last time the MSR was read.
0	R	0x0	Delta Clear to Send. This is used to indicate that the modem control line cts_n has changed since the last time the MSR was read.

UART_SCR

Address: Operational Base + offset(0x1C)

Scratchpad Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	RW	0x0	This register is for programmers to use as a temporary storage space.

UART_SRBR

Address: Operational Base + offset(0x30-6C)

Shadow Receive Buffer Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	R	0x0	This is a shadow register for the RBR and has been allocated sixteen 32-bit locations so as to accommodate burst accesses from the master. This register contains the data byte received on the serial

			<p>input port (sin) in UART mode or the serial infrared input (sir_in) in infrared mode. The data in this register is valid only if the Data Ready (DR) bit in the Line status Register (LSR) is set.</p> <p>If FIFOs are disabled (FCR[0] set to zero), the data in the RBR must be read before the next data arrives, otherwise it is overwritten, resulting in an overrun error.</p> <p>If FIFOs are enabled (FCR[0] set to one), this register accesses the head of the receive FIFO. If the receive FIFO is full and this register is not read before the next data character arrives, then the data already in the FIFO are preserved, but any incoming data is lost. An overrun error also occurs</p>
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UART_STHR

Address: Operational Base + offset(0x30-6C)

Shadow Transmit Holding Register

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	R	0x0	This is a shadow register for the THR.

UART_FAR

Address: Operational Base + offset(0x70)

FIFO Access Register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x0	<p>This register is use to enable a FIFO access mode for testing, so that the receive FIFO can be written by the master and the transmit FIFO can be read by the master when FIFOs are implemented and enabled. When FIFOs are not enabled it allows the RBR to be written by the master and the THR to be read by the master.</p> <p>0 = FIFO access mode disabled 1 = FIFO access mode enabled</p>

UART_TFR

Address: Operational Base + offset(0x74)

Transmit FIFO Read

Bit	Attr	Reset Value	Description
31:8	-	-	Reserved
7:0	R	0x0	<p>Transmit FIFO Read. These bits are only valid when FIFO access mode is enabled (FAR[0] is set to one). When FIFOs are implemented and enabled, reading this register gives the data at the top of the transmit FIFO. Each consecutive read pops the transmit FIFO and gives the next data value that is currently at the top of the FIFO.</p> <p>When FIFOs are not implemented or not enabled, reading this register gives the data in the THR.</p>

UART_RFW

Address: Operational Base + offset(0x78)

Receive FIFO Write

Bit	Attr	Reset Value	Description
31:10	-	-	Reserved
9	W	0x0	Receive FIFO Framing Error. These bits are only valid when FIFO access mode is enabled (FAR[0] is set to one).
8	W	0x0	Receive FIFO Parity Error. These bits are only valid when FIFO access mode is enabled (FAR[0] is set to one).
7:0	W	0x0	Receive FIFO Write Data. These bits are only valid when FIFO access mode is enabled (FAR[0] is set to one). When FIFOs are enabled, the data that is written to the RFWD is pushed into the receive FIFO. Each consecutive write pushes the new data to the next write location in the receive FIFO. When FIFOs not enabled, the data that is written to the RFWD is pushed into the RBR.

UART_USR

Address: Operational Base + offset(0x7C)

UART Status Register

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved
4	R	0x0	Receive FIFO Full. This is used to indicate that the receive FIFO is completely full. 0 = Receive FIFO not full 1 = Receive FIFO Full This bit is cleared when the RX FIFO is no longer full
3	R	0x0	Receive FIFO Not Empty. This is used to indicate that the receive FIFO contains one or more entries. 0 = Receive FIFO is empty 1 = Receive FIFO is not empty This bit is cleared when the RX FIFO is empty
2	R	0x1	Transmit FIFO Empty. This is used to indicate that the transmit FIFO is completely empty. 0 = Transmit FIFO is not empty 1 = Transmit FIFO is empty This bit is cleared when the TX FIFO is no longer empty
1	R	0x1	Transmit FIFO Not Full. This is used to indicate that the transmit FIFO is not full. 0 = Transmit FIFO is full 1 = Transmit FIFO is not full This bit is cleared when the TX FIFO is full.
0	R	0x0	UART Busy. This indicates that a serial transfer is in progress, when cleared indicates that the uart is idle or inactive. 0 = Uart is idle or inactive 1 = Uart is busy (actively transferring data)

UART_TFL

Address: Operational Base + offset(0x80)

Transmit FIFO Level

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved
4:0	R	0x0	Transmit FIFO Level. This indicates the number of data entries in the transmit FIFO.

UART_RFL

Address: Operational Base + offset(0x84)

Receive FIFO Level

Bit	Attr	Reset Value	Description
31:5	-	-	Reserved
4:0	R	0x0	Receive FIFO Level. This indicates the number of data entries in the receive FIFO.

UART_SRR

Address: Operational Base + offset(0x88)

Software Reset Register

Bit	Attr	Reset Value	Description
31:3	-	-	Reserved
2	W	0x0	XMIT FIFO Reset. This is a shadow register for the XMIT FIFO Reset bit (FCR[2]).
1	W	0x0	RCVR FIFO Reset. This is a shadow register for the RCVR FIFO Reset bit (FCR[1]).
0	W	0x0	UART Reset. This asynchronously resets the Uart and synchronously removes the reset assertion. For a two clock implementation both pclk and sclk domains are reset.

UART_SRTS

Address: Operational Base + offset(0x8C)

Shadow Request to Send

Bit	Attr	Reset Value	Description
31:1	-	-	
0	RW	0x0	Shadow Request to Send. This is a shadow register for the RTS bit (MCR[1]), this can be used to remove the burden of having to performing a read-modify-write on the MCR.

UART_SBCR

Address: Operational Base + offset(0x90)

Shadow Break Control Register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x0	Shadow Break Control Bit. This is a shadow register for the Break bit (LCR[6]), this can be used to remove the burden of having to performing a read modify write on the LCR.

UART_SDMAM

Address: Operational Base + offset(0x94)

Shadow DMA Mode

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x0	Shadow DMA Mode. This is a shadow register for the

		DMA mode bit (FCR[3]).
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UART_SFE

Address: Operational Base + offset(0x98)

Shadow FIFO Enable

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x0	Shadow FIFO Enable. This is a shadow register for the FIFO enable bit (FCR[0]).

UART_SRT

Address: Operational Base + offset(0x9C)

Shadow RCVR Trigger

Bit	Attr	Reset Value	Description
31:2	-	-	Reserved
1:0	RW	0x0	Shadow RCVR Trigger. This is a shadow register for the RCVR trigger bits (FCR[7:6]).

UART_STET

Address: Operational Base + offset(0xa0)

Shadow TX Empty Trigger

Bit	Attr	Reset Value	Description
31:2	-	-	Reserved
1:0	RW	0x0	Shadow TX Empty Trigger. This is a shadow register for the TX empty trigger bits (FCR[5:4]).

UART_HTX

Address: Operational Base + offset(0xa4)

Halt TX

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x0	This register is used to halt transmissions for testing, so that the transmit FIFO can be filled by the master when FIFOs are implemented and enabled. 0 = Halt TX disabled 1 = Halt TX enabled

UART_DMASA

Address: Operational Base + offset(0xa8)

RTC counter reset register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	W	0x0	This register is used to perform a DMA software acknowledge if a transfer needs to be terminated due to an error condition.

UART_UCV

Address: Operational Base + offset(0xf8)

UART Component Version

Bit	Attr	Reset Value	Description
31:0	R	0x330372a	ASCII value for each number in the version

UART_CTR

Address: Operational Base + offset(0xfc)

Component Type Register

Bit	Attr	Reset Value	Description
31:0	R	0x44570110	This register contains the peripherals identification code.

Notes: Attr: **RW** – Read/writable, **R** – read only, **W** – write only

35.5 Interface description

Table 35- 1 UART Interface Description

Module pin	Direction	Pad name	IOMUX
UART0 Interface			
uart0_sin	I	GPIO1_A[0]	GRF_GPIO1A_IOMUX[0]=1
uart0_sout	O	GPIO1_A[1]	GRF_GPIO1A_IOMUX[2]=1
uart0_cts_n	I	GPIO1_A[2]	GRF_GPIO1A_IOMUX[4]=1
uart0_rts_n	O	GPIO1_A[3]	GRF_GPIO1A_IOMUX[6]=1
UART1 Interface			
uart1_sin	I	GPIO1_A[4]	GRF_GPIO1A_IOMUX[9:8]=01
uart1_sout	O	GPIO1_A[5]	GRF_GPIO1A_IOMUX[11:10]=01
uart1_cts_n	I	GPIO1_A[6]	GRF_GPIO1A_IOMUX[13:12]=01
uart1_rts_n	O	GPIO1_A[7]	GRF_GPIO1A_IOMUX[15:14]=01
UART2 Interface			
uart2_sin	I	GPIO1_B[0]	GRF_GPIO1B_IOMUX[1:0]=01
uart2_sout	O	GPIO1_B[1]	GRF_GPIO1B_IOMUX[3:2]=01
UART3 Interface			
uart3_sin	I	GPIO3_D[3]	GRF_GPIO3D_IOMUX[7:6]=01
uart3_sout	O	GPIO3_D[4]	GRF_GPIO3D_IOMUX[9:8]=01
uart3_cts_n	I	GPIO3_D[5]	GRF_GPIO3D_IOMUX[11:10]=01
uart3_rts_n	O	GPIO3_D[6]	GRF_GPIO3D_IOMUX[13:12]=01

35.6 Application Notes

35.6.1 None FIFO Mode Transfer Flow

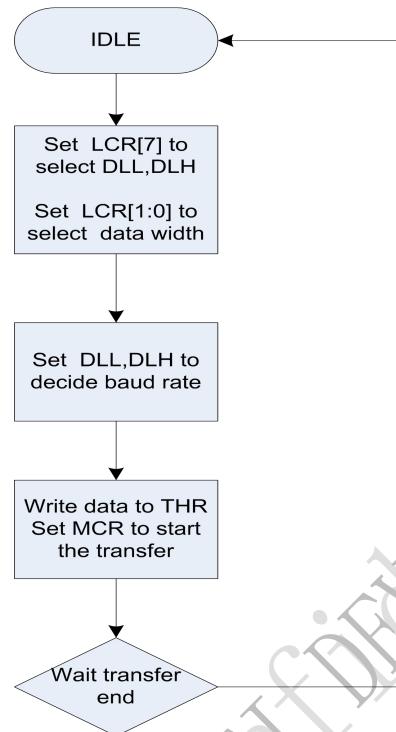


Fig. 35- 7UARTnone fifo mode

35.6.2 FIFO Mode Transfer Flow

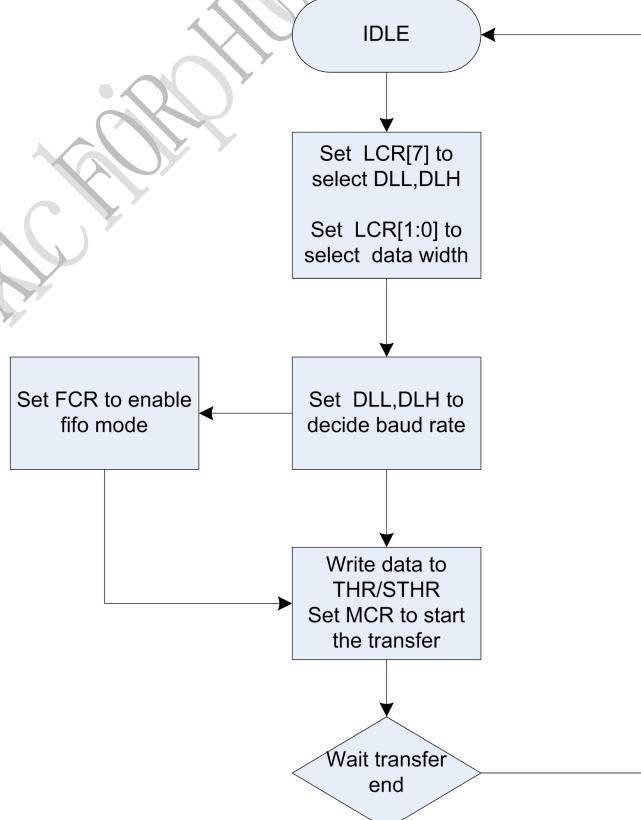


Fig. 35- 8UART fifo mode

The UART is an APB slave performing:

Serial-to-parallel conversion on data received from a peripheral device.

Parallel-to-serial conversion on data transmitted to the peripheral device.

The CPU reads and writes data and control/status information through the APB interface. The transmitting and receiving paths are buffered with internal FIFO memories enabling up to 32-bytes to be stored independently in both transmit and receive modes. A baud rate generator can generate a common transmit and receive internal clock input. The baud rates will depend on the internal clock frequency. The UART will also provide transmit, receive and exception interrupts to system. A DMA interface is implemented for improving the system performance.

35.6.3 Baud Rate Calculation

- UART clock generation

Fig.36-10 shows the UART clock generation.

UART source clocks can be selected from CODEC PLL and GENERAL PLL outputs.

UART clocks can be generated by 1 to 64 division of its source clock , or can be fractionally divided again , or be provided by XIN24M.

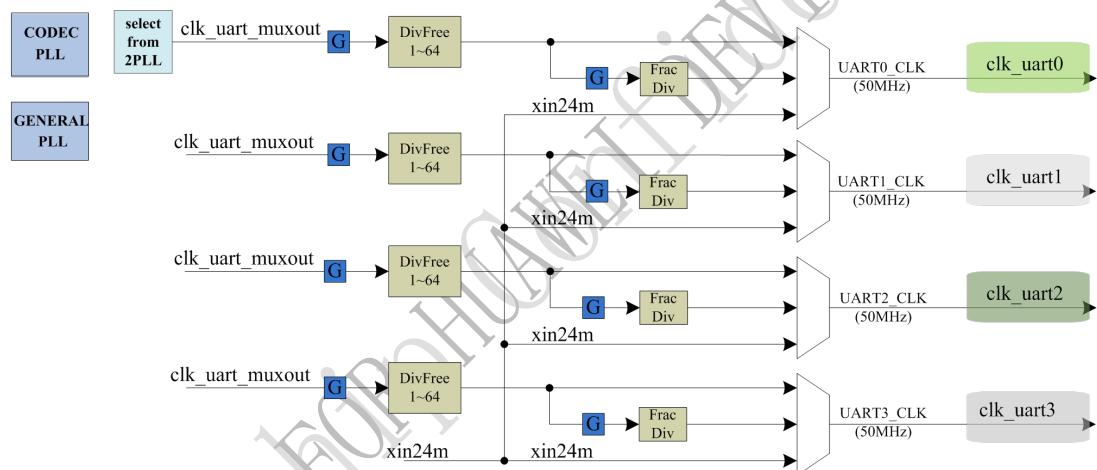


Fig. 35- 9 UART clock generation

- UART baud rate configuration

Table 36-2 provides some reference configuration for different UART baud rates.

Table 35- 2 UART baud rate configuration

Baud Rate	Reference Configuration
115.2 Kbps	Config GENERAL PLL to get 648MHz clock output; Divide 648MHz clock by 1152/50625 to get 14.7456MHz clock; Config UART_DLL to 8.
460.8 Kbps	Config GENERAL PLL to get 648MHz clock output; Divide 648MHz clock by 1152/50625 to get 14.7456MHz clock; Config UART_DLL to 2.
921.6 Kbps	Config GENERAL PLL to get 648MHz clock output; Divide 648MHz clock by 1152/50625 to get 14.7456MHz clock; Config UART_DLL to 1.
1.5 Mbps	Choose GENERAL PLL to get 384MHz clock output; Divide 384MHz clock by 16 to get 24MHz clock;

	Config UART_DLL to 1
3 Mbps	Choose GENERAL PLL to get 384MHz clock output; Divide 384MHz clock by 8 to get 48MHz clock; Config UART_DLL to 1
4 Mbps	Config GENERAL PLL to get 384MHz clock output; Divide 384MHz clock by 6 to get 64MHz clock; Config UART_DLL to 1

Chapter 36 I2C Interface

36.1 Overview

The Inter-Integrated Circuit (I2C) is a two wired (SCL and SDA), bi-directional serial bus that provides an efficient and simple method of information exchange between devices. This I2C bus controller supports master mode acting as a bridge between AMBA protocol and generic I2C bus system.

36.1.1 Features

- Item Compatible with I2C-bus
- AMBA APB slave interface
- Supports master mode of I2C bus
- Software programmable clock frequency and transfer rate up to 400Kbit/sec
- Supports 7 bits and 10 bits addressing modes
- Interrupt or polling driven multiple bytes data transfer
- Clock stretching and wait state generation
- I2C0/I2C1 is in cpu system, I2C2 /I2C3 /I2C4 are in peri system

36.2 Block Diagram

This chapter provides a description about the functions and behavior under various conditions.

APB BUS

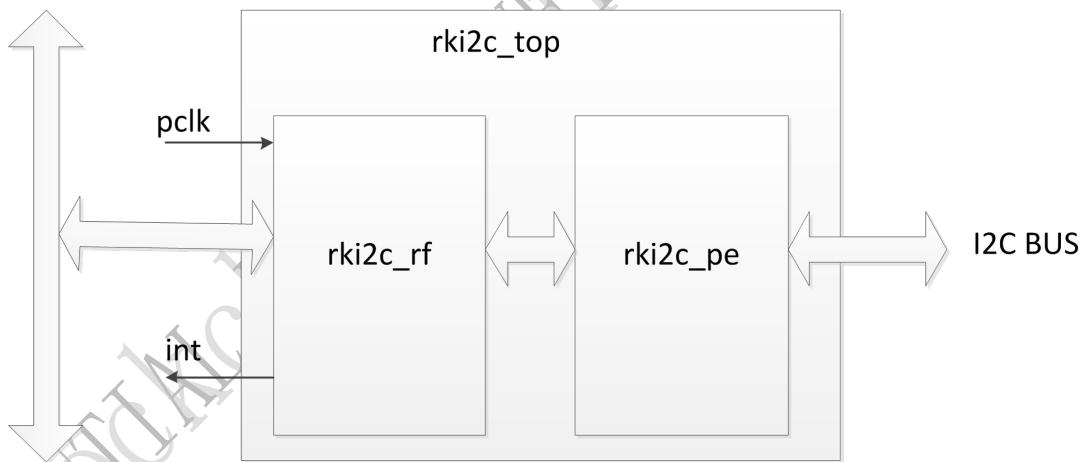


Fig. 36- 1I2C architechture

I2C_rf

I2C_rf module is used to control the I2C controller operation by the host with APB interface. It implements the register set and the interrupt functionality. The CSR component operates synchronously with the pclk clock.

I2C_pe

I2C_pe module implements the I2C master operation for transmit data to and receive data from other I2C devices. The I2C master controller operates synchronously with the pclk.

I2C_top

I2C_top module is the top module of the I2C controller.

36.3 Function description

The I2C controller supports only Masterfunction. It supports the 7-bits/10-bits addressing mode and support general call address. The maximum clock frequency and transfer rate can be up to 400Kbit/sec.

The operations of I2C controller is divided to 2 parts and described separately: initialization and master mode programming.

Initialization

The I2C controller is based on AMBA APB bus architecture and usually is part of a SOC. So before I2C operates, some system setting & configuration must be conformed, which includes:

- I2C interrupt connection type: CPU interrupt scheme should be considered. If the I2C interrupt is connected to extra Interrupt Controller module, we need decide the INTC vector.
- I2C Clock Rate: The I2C controller uses the APB clock as the system clock so the APB clock will determine the I2C bus clock. The correct register setting is subject to the system requirement.

Master Mode Programming

SCL Clock: When the I2C controller is programmed in Master mode, the SCL frequency is determined by I2C_CLKDIV register. The SCL frequency is calculated by the following formula

$$\text{SCL Divisor} = 8 * (\text{CLKDIVL} + \text{CLKDIVH})$$

$$\text{SCL} = \text{PCLK} / \text{SCLK Divisor}$$

Data Receiver Register Access

When the i2c controller received MRXCNT bytes data, CPU can get the datas through register RXDATA0 ~ RXDATA7. The controller can receive up to 32 byte datas in one transaction.

When MRXCNT register is written, the I2C controller will start to drive SCL to receive datas.

Transmit Trasmitter Register

Datas to transmit are written to TXDATA0~7 by CPU. The controller can transmit up to 32 byte datas in one transaction. The lower byte will be transmitted first.

When MTXCNT register is written, the I2C controller will start to transmit datas.

Start Command

Write 1 to I2C_CON[3], the controller will send I2C start command.

Stop Command

Write 1 to I2C_CON[4], the controller will send I2C stop command

I2C Operation mode

There are four i2c operation mode.

When I2C_CON[2:1] is 2'b00, the controller transmit all valid datas in TXDATA0~TXDATA7 byte by byte. The controller will transmit lower byte first.

When I2C_CON[2:1] is 2'b01, the controller will transmit device address in MRXADDR first (Write/Read bit = 0) and then transmit device register address in

MRXRADDR. After that, the controller will assert restart signal and resend MRXADDR (Write/Read bit = 1). At last , the controller enter receive mode .

When I2C_CON[2:1] is 2'b10, the controller is in receive mode, it will triggered clock to read MRXCNT byte datas.

When I2C_CON[2:1] is 2'b11,the controller will transmit device address in MRXADDR first (Write/Read bit = 1) and then transmit device register address in MRXRADDR . After that, the controller will assert restart signal and resend MRXADDR (Write/Read bit = 1). At last , the controller enter receive mode .

Read/Write Command

When I2C_OPMODE(I2C_CON[2:1]) is 2'b01 or 2'b11, the Read/Write command bit is decided by controller itself.

In RX only mode (I2C_CON[2:1] is 2'b10), the Read/Write command bit is decided by MRXADDR[0].

In TX only mode (I2C_CON[[2:1] is 2'b00), the Read/Write command bit is decided by TXDATA[0].

Master Interrupt Condition

There are 7 interrupt bits in I2C_ISR register related to master mode.

Byte transfer finish interrupt (Bit 0): The bit is asserted when Master finish transferring a byte .

Byte received finish interrupt (Bit 1): The bit is asserted when Master finish receiving a byte.

MTXCNT bytes data transfer finish interrupt (Bit 2): The bit is asserted when Master finish transferring MTXCNT bytes.

MRXCNT bytes data received finish interrupt (Bit 3): The bit is asserted when Master finish receiving MRXCNT bytes.

Start interrupt (Bit 4) : The bit is asserted when Master finish asserting start command to I2C bus.

Stop interrupt (Bit 5) : The bit is asserted when Master finish asserting stop command to I2C bus.

Nak received interrupt (Bit 6): The bit is asserted when Master receive a NAK handshake.

Last byte acknowledge control

If I2C_CON[5] is 1, the I2C controller will transmit NAK handshake to slave when the last byte received in RX only mode.

If I2C_CON[5] is 0, the I2C controller will transmit ACK handshake to slave when the last byte received in RX only mode.

How to handle nak handshake received

If I2C_CON[6] is 1, the I2C controller will stop all transactions when nak handshake received. And the software should take responsibility to handle the problem.

If I2C_CON[6] is 0, the I2C controller will ignore all nak handshake received.

I2C controller data transfer waveform

● Bit transferring

(a) Data Validity

The SDA line must be stable during the high period of SCL, and the data on SDA line can only be changed when SCL is in low state.

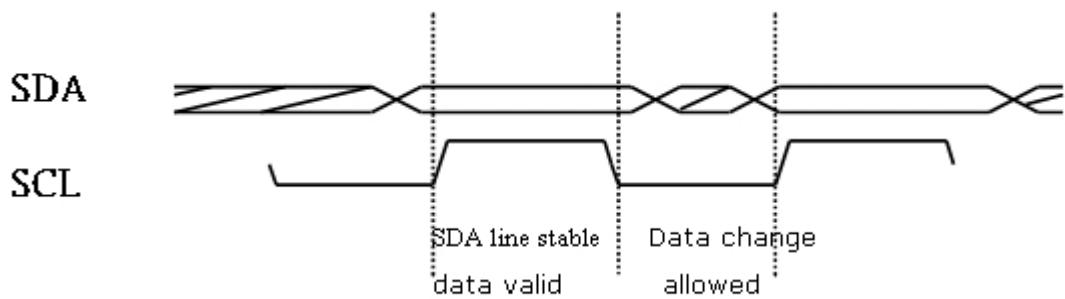


Fig. 36- 2I2C DATA Validity

(b) START and STOP conditions

START condition occurs when SDA goes low while SCL is in high period. STOP condition is generated when SDA line goes high while SCL is in high state.

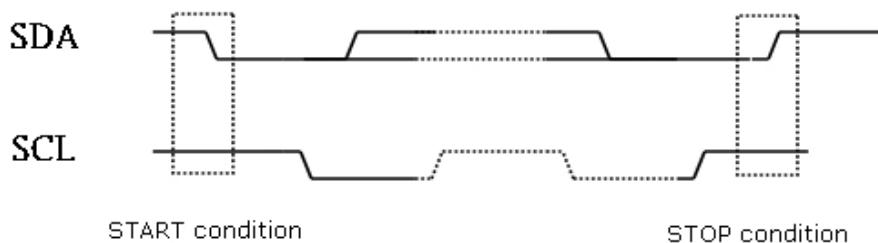


Fig. 36- 3 I2C Start and stop conditions

● Data transfer

(a) Acknowledge

After a byte of data transferring (clocks labeled as 1~8), in 9th clock the receiver must assert an ACK signal on SDA line, if the receiver pulls SDA line to low, it means "ACK", on the contrary, it's "NOT ACK".

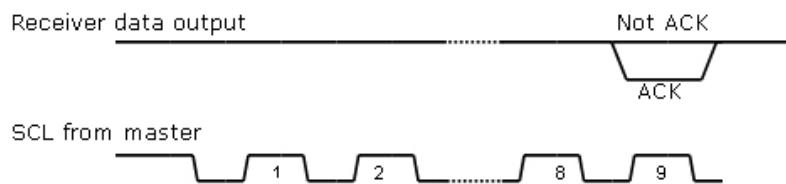


Fig. 36- 4I2C Acknowledge

(b) Byte transfer

The master own I2C bus might initiate multi byte ot transfers to a slave, the transfers starts from a "START" command and ends in a "STOP"command. After every byte transfer, the receiver must reply an ACK to transmitter.

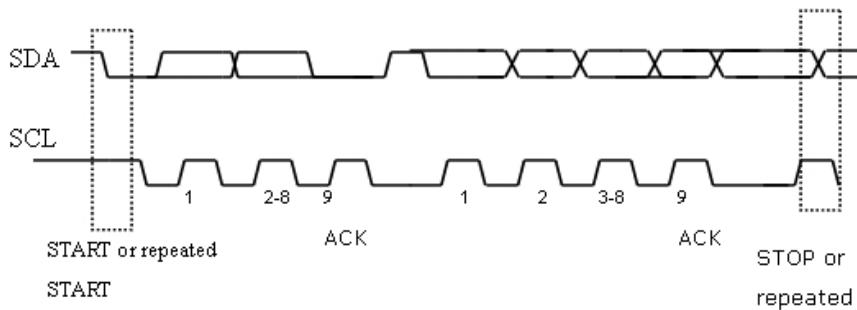


Fig. 36-5 I2C byte transfer

36.4 Register description

36.4.1 Register Summary

Name	Offset	Size	Reset Value	Description
I2C_CON	0x0000	W	0x00000000	control register
I2C_CLKDIV	0x0004	W	0x00000001	Clock divisor register
I2C_MRXCADDR	0x0008	W	0x00000000	the slave address accessed for master rx mode
I2C_MRXRADDR	0x000c	W	0x00000000	the slave register address accessed for master rx mode
I2C_MTXCNT	0x0010	W	0x00000000	master transmit count
I2C_MRXCNT	0x0014	W	0x00000000	master rx count
I2C_IEN	0x0018	W	0x00000000	interrupt enable register
I2C_IPD	0x001c	W	0x00000000	interrupt pending register
I2C_FCNT	0x0020	W	0x00000000	finished count
I2C_TXDATA0	0x0100	W	0x00000000	I2C tx data register 0
I2C_TXDATA1	0x0104	W	0x00000000	I2C tx data register 1
I2C_TXDATA2	0x0108	W	0x00000000	I2C tx data register 2
I2C_TXDATA3	0x010c	W	0x00000000	I2C tx data register 3
I2C_TXDATA4	0x0110	W	0x00000000	I2C tx data register 4
I2C_TXDATA5	0x0114	W	0x00000000	I2C tx data register 5
I2C_TXDATA6	0x0118	W	0x00000000	I2C tx data register 6
I2C_TXDATA7	0x011c	W	0x00000000	I2C tx data register 7
I2C_RXDATA0	0x0200	W	0x00000000	I2C rx data register 0
I2C_RXDATA1	0x0204	W	0x00000000	I2C rx data register 1
I2C_RXDATA2	0x0208	W	0x00000000	I2C rx data register 2
I2C_RXDATA3	0x020c	W	0x00000000	I2C rx data register 3
I2C_RXDATA4	0x0210	W	0x00000000	I2C rx data register 4
I2C_RXDATA5	0x0214	W	0x00000000	I2C rx data register 5
I2C_RXDATA6	0x0218	W	0x00000000	I2C rx data register 6
I2C_RXDATA7	0x021c	W	0x00000000	I2C rx data register 7

Notes: **S**-Size: **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

36.4.2 Detail Register Description

I2C_CON

Address: Operational Base + offset (0x0000)
control register

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6	RW	0x0	act2nak operation when nak handshake is received 0: ignored 1: stop transaction
5	RW	0x0	ack last byte acknowledge control last byte acknowledge control in master rx mode . 0: ack 1: nak
4	W1C	0x0	stop stop enable when this bit is written to 1, I2C will generate stop signal. It cleared itself when stop operation ends.
3	W1C	0x0	start start enable when this bit is written to 1, I2C will generate start signal. It cleared itself when start operation ends.
2:1	RW	0x0	i2c_mode 00: tx only 01: tx address (device + register address) --> restart --> tx address ->rx only 10:rx only 11: tx address (device + register address, write/read bit is 1) --> restart --> tx address (device address) --> rx data
0	RW	0x0	i2c_en i2c module enable

I2C_CLKDIV

Address: Operational Base + offset (0x0004)
Clock divisor register

Bit	Attr	Reset Value	Description
------------	-------------	--------------------	--------------------

Bit	Attr	Reset Value	Description
31:16	RW	0x0000	CLKDIVH scl high level clock count $T(\text{SCL_HIGH}) = T(\text{PCLK}) * \text{CLKDIVH} * 8$
15:0	RW	0x0001	CLKDIVL scl low level clock count $T(\text{SCL_LOW}) = T(\text{PCLK}) * \text{CLKDIVL} * 8$

I2C_MRXADDR

Address: Operational Base + offset (0x0008)
the slave address accessed for master rx mode

Bit	Attr	Reset Value	Description
31:27	RO	0x0	reserved
26	RW	0x0	addhvld address high byte valid
25	RW	0x0	addmvld address middle byte valid
24	RW	0x0	addlvld address low byte valid
23:0	RW	0x000000	saddr master address register the lowest bit indicate write or read

I2C_MRXRADDR

Address: Operational Base + offset (0x000c)
the slave register address accessed for master rx mode

Bit	Attr	Reset Value	Description
31:27	RO	0x0	reserved
26	RW	0x0	sraddhvld address high byte valid
25	RW	0x0	sraddmvld address middle byte valid
24	RW	0x0	sraddlvld address low byte valid
23:0	RW	0x000000	sraddr slave register address accessed

I2C_MTXCNT

Address: Operational Base + offset (0x0010)
master transmit count

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved

Bit	Attr	Reset Value	Description
5:0	RW	0x00	mtxcnt master transmit count

I2C_MRXCNT

Address: Operational Base + offset (0x0014)
master rx count

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x00	mrxcnt master rx count

I2C_IEN

Address: Operational Base + offset (0x0018)
interrupt enable register

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6	RW	0x0	nakrcvien nak handshake received interrupt enable
5	RW	0x0	stopien stop operation finished interrupt enable
4	RW	0x0	startien start operation finished interrupt enable
3	RW	0x0	mbrfien MRXCNT data received finished interrupt enable
2	RW	0x0	mbtfien MTXCNT data transfer finished interrupt enable
1	RW	0x0	brfien byte rx finished interrupt enable
0	RW	0x0	btfien byte tx finished interrupt enable

I2C_IPD

Address: Operational Base + offset (0x001c)
interrupt pending register

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved
6	RW	0x0	nakrcvipd nak handshake received interrupt pending bit
5	RW	0x0	stopipd stop operation finished interrupt pending bit

Bit	Attr	Reset Value	Description
4	RW	0x0	startipd start operation finished interrupt pending bit
3	RW	0x0	mbrfipd MRXCNT data received finished interrupt pending bit
2	RW	0x0	mbtfipd MTXCNT data transfer finished interrupt pending bit
1	RW	0x0	brfipd byte rx finished interrupt pending bit
0	RW	0x0	btfipd byte tx finished interrupt pending bit

I2C_FCNT

Address: Operational Base + offset (0x0020)
finished count

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x00	fcnt finished count the count of data which has been transmitted or received for debug purpose

I2C_TXDATA0

Address: Operational Base + offset (0x0100)
I2C tx data register 0

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	txdata0

I2C_TXDATA1

Address: Operational Base + offset (0x0104)
I2C tx data register 1

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	txdata1

I2C_TXDATA2

Address: Operational Base + offset (0x0108)
I2C tx data register 2

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	txdata2

I2C_TXDATA3

Address: Operational Base + offset (0x010c)
I2C tx data register 3

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	txdata3

I2C_TXDATA4

Address: Operational Base + offset (0x0110)
I2C tx data register 4

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	txdata4

I2C_TXDATA5

Address: Operational Base + offset (0x0114)
I2C tx data register 5

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	txdata5

I2C_TXDATA6

Address: Operational Base + offset (0x0118)
I2C tx data register 6

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	txdata6

I2C_RXDATA0

Address: Operational Base + offset (0x0200)
I2C rx data register 0

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata0

I2C_RXDATA1

Address: Operational Base + offset (0x0204)
I2C rx data register 1

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata1

I2C_RXDATA2

Address: Operational Base + offset (0x0208)
I2C rx data register 2

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata2

I2C_RXDATA3

Address: Operational Base + offset (0x020c)
I2C rx data register 3

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata3

I2C_RXDATA4

Address: Operational Base + offset (0x0210)
I2C rx data register 4

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata4

I2C_RXDATA5

Address: Operational Base + offset (0x0214)
I2C rx data register 5

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata5

I2C_RXDATA6

Address: Operational Base + offset (0x0218)
I2C rx data register 6

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata6

I2C_RXDATA7

Address: Operational Base + offset (0x021c)
I2C rx data register 7

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	rxdata7

36.5 Timing Diagram

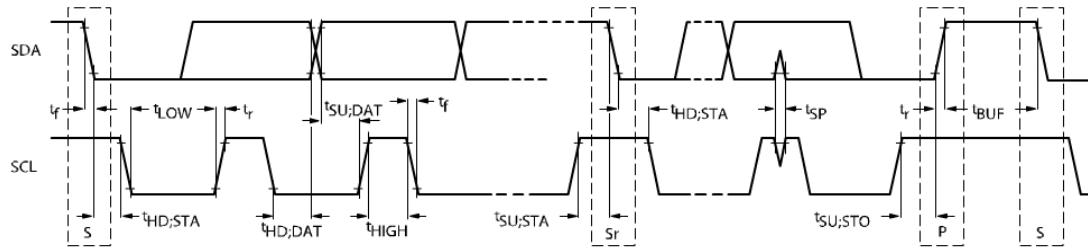


Fig. 36- 6 I2C timing diagram

Table 36- 1 I2C timing parameters

Parameter	Description	min	typ	max	unit
100Khz mode					
f_{SCL}	SCL clock frequency	-	100	-	KHz
$T_{HD:DAT}$	SDA hold time to rising edge of SCL	-	2.5	-	us
$T_{SU:DAT}$	SDA setup time to rising edge of SCL	-	2.5	-	us
t_{LOW}	Low period of SCL	-	5	-	us
t_{HIGH}	High period of SCL	-	5	-	us
400Khz mode					
f_{SCL}	SCL clock frequency	-	400	-	KHz
$T_{HD:DAT}$	SDA hold time to rising edge of SCL	-	0.625	-	us
$T_{SU:DAT}$	SDA setup time to rising edge of SCL	-	0.625	-	us
t_{LOW}	Low period of SCL	-	1.25	-	us
t_{HIGH}	High period of SCL	-	1.25	-	us

36.6 Interface description

Table 36- 2 I2C Interface Description

Module pin	Direction	Pad name	IOMUX
I2C0 Interface			
i2c0_sda	I/O	GPIO1_D[0]	GRF_GPIO1D_IOMUX[0]=1
i2c0_scl	I/O	GPIO1_D[1]	GRF_GPIO1D_IOMUX[2]=1
I2C1 Interface			
i2c1_sda	I/O	GPIO1_D[2]	GRF_GPIO1D_IOMUX[4]=1
i2c1_scl	I/O	GPIO1_D[3]	GRF_GPIO1D_IOMUX[6]=1
I2C2 Interface			
i2c2_sda	I/O	GPIO1_A[4]	GRF_GPIO1D_IOMUX[8]=1
i2c2_scl	I/O	GPIO1_A[5]	GRF_GPIO1D_IOMUX[10]=1
I2C3 Interface			
i2c3_sda	I/O	GPIO3_B[6]	GRF_GPIO3B_IOMUX[13:12]=10
i2c3_scl	I/O	GPIO3_B[7]	GRF_GPIO3B_IOMUX[15:14]=10
I2C4 Interface			
i2c4_sda	I/O	GPIO1_D[6]	GRF_GPIO1D_IOMUX[12]=1
i2c4_scl	I/O	GPIO1_D[7]	GRF_GPIO1D_IOMUX[14]=1

36.7 Application Notes

The I2C controller core operation flow chart below is to describe how the software configures and performs an I2C transaction through this I2C controller core. Descriptions are divided into 3 sections, transmit only mode, receive only mode, and mix mode . Users are strongly advised to following.

- Transmit only mode (I2C_CON[1:0]=2'b00)

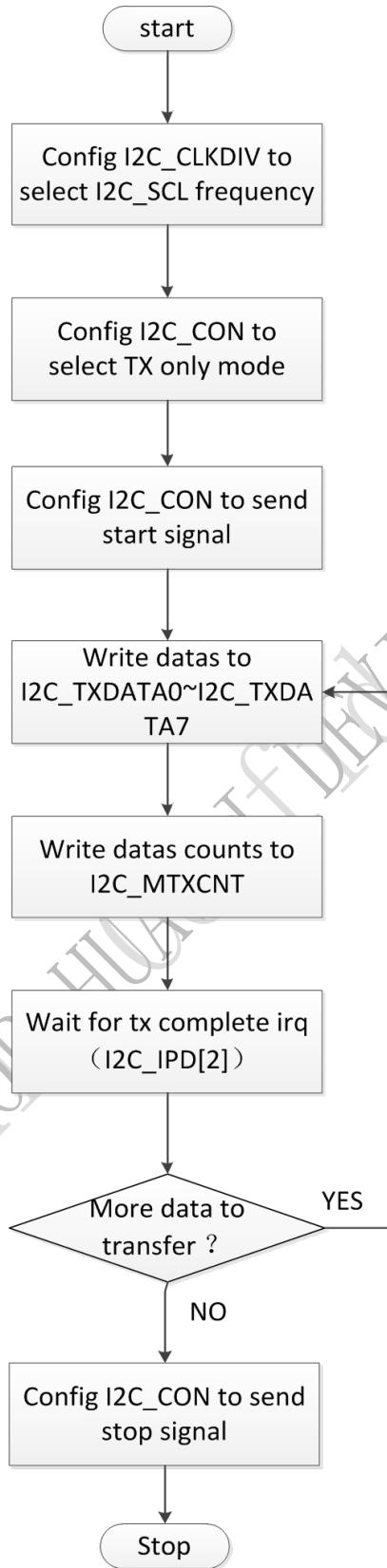


Fig. 36- 7I2C Flow chat for tx only mode

- Receive only mode ($I2C_CON[1:0]=2'b10$)

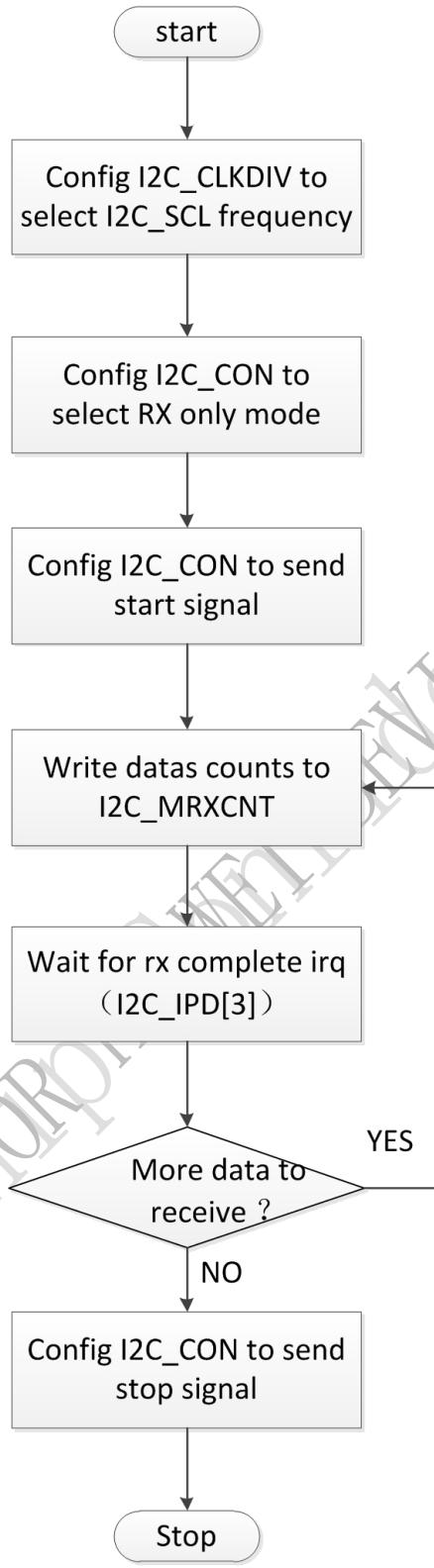


Fig. 36-8I2C Flow chat for rx only mode

- Mix mode ($I2C_CON[1:0]=2'b01$ or $I2C_CON[1:0]=2'b10$)

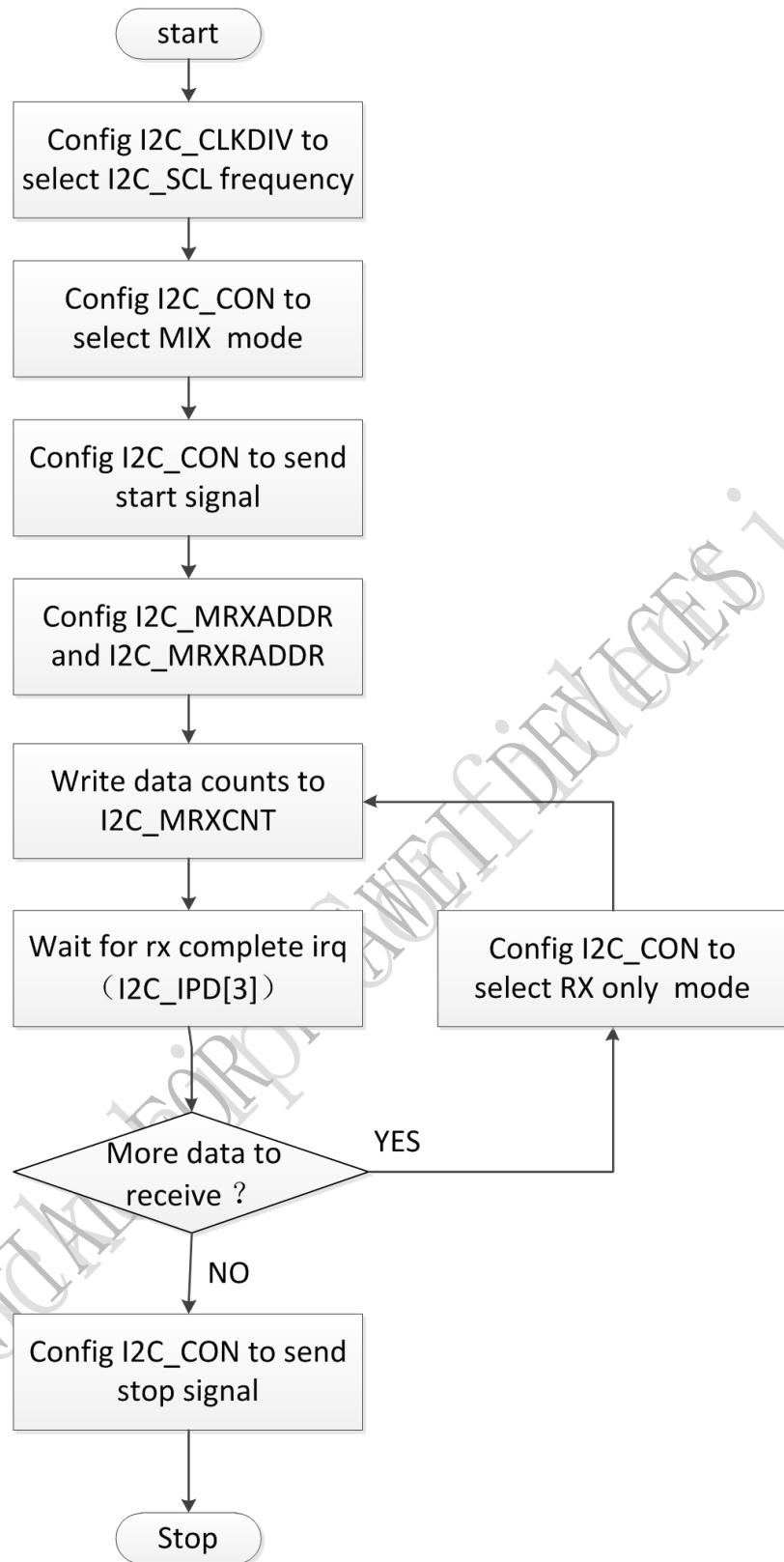


Fig. 36-9 I2C Flow chart for mix mode

Chapter 37 GPIO

37.1 Overview

GPIO is a programmable General Purpose Programming I/O peripheral. This component is a APB slave device. GPIO controls the output data and direction of external I/O pads. It also can read back the data on external pads using memory-mapped registers.

The features of GPIO are as follow:

- 32 bits APB bus width
- 32 independently configurable signals
- Separate data registers and data direction registers for each signal
- Software control for each signal, or for each bit of each signal
- Configurable interrupt mode for Port A
- Port A has 32 bits

Notes: Port A 32bits are corresponding to port A/B/C/D 8bits in Chapter1

37.2 Block Diagram

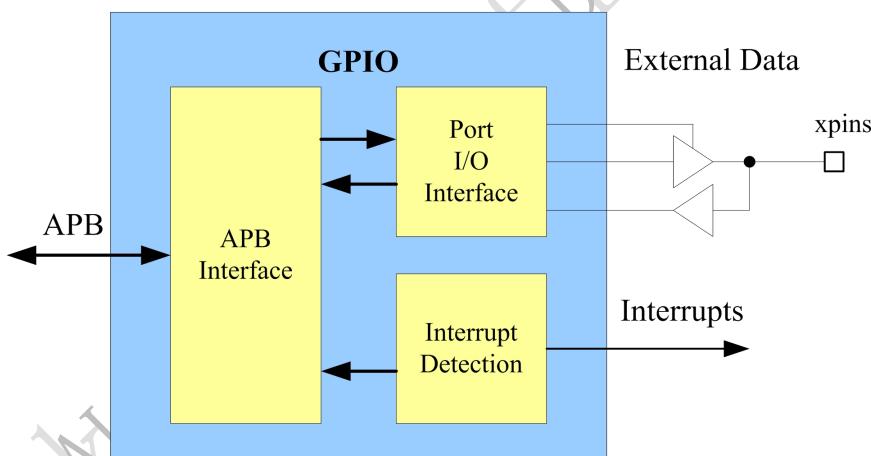


Fig. 37- 1GPIO block diagram

Block descriptions:

APB Interface

The APB Interface implements the APB slave operation. Its bus width is 32 bits.

Port I/O Interface

External data interface to or from I/O pads.

Interrupt Detection

Interrupt interface to or from interrupt controller.

37.3 Function description

37.3.1 Operation

Control Mode(software)

Under software control, the data and direction control for the signal are sourced from the data register (GPIO_SWPORTA_DR) and direction control register (GPIO_SWPORTA_DDR).

The direction of the external I/O pad is controlled by a write to the Porta data direction register (GPIO_SWPORTA_DDR). The data written to this memory-mapped register gets mapped onto an output signal, GPIO_PORTA_DDR, of the GPIO peripheral. This output signal controls the direction of an external I/O pad.

The data written to the Porta data register (GPIO_SWPORTA_DR) drives the output buffer of the I/O pad. External data are input on the external data signal, GPIO_EXT_PORTA. Reading the external signal register (GPIO_EXT_PORTA) shows the value on the signal, regardless of the direction. This register is read-only, meaning that it cannot be written from the APB software interface.

Reading External Signals

The data on the GPIO_EXT_PORTA external signal can always be read. The data on the external GPIO signal is read by an APB read of the memory-mapped register, GPIO_EXT_PORTA.

An APB read to the GPIO_EXT_PORTA register yields a value equal to that which is on the GPIO_EXT_PORTA signal.

Interrupts

Port A can be programmed to accept external signals as interrupt sources on any of the bits of the signal. The type of interrupt is programmable with one of the following settings:

- Active-high and level
- Active-low and level
- Rising edge
- Falling edge

The interrupts can be masked by programming the GPIO_INTMASK register. The interrupt status can be read before masking (called raw status) and after masking.

The interrupts are combined into a single interrupt output signal, which has the same polarity as the individual interrupts. In order to mask the combined interrupt, all individual interrupts have to be masked. The single combined interrupt does not have its own mask bit.

Whenever Port A is configured for interrupts, the data direction must be set to Input. If the data direction register is reprogrammed to Output, then any pending interrupts are not lost. However, no new interrupts are generated.

For edge-detected interrupts, the ISR can clear the interrupt by writing a 1 to the GPIO_PORTA_EOI register for the corresponding bit to disable the interrupt. This write also clears the interrupt status and raw status registers. Writing to the GPIO_PORTA_EOI register has no effect on level-sensitive interrupts. If level-sensitive interrupts cause the processor to interrupt, then the ISR can poll the GPIO_INT_RAWSTATUS register until the interrupt source disappears, or it can write to the GPIO_INTMASK register to mask the interrupt before exiting the ISR. If the ISR exits without masking or disabling the interrupt prior to exiting, then the level-sensitive interrupt repeatedly requests an interrupt until the interrupt is cleared at the source.

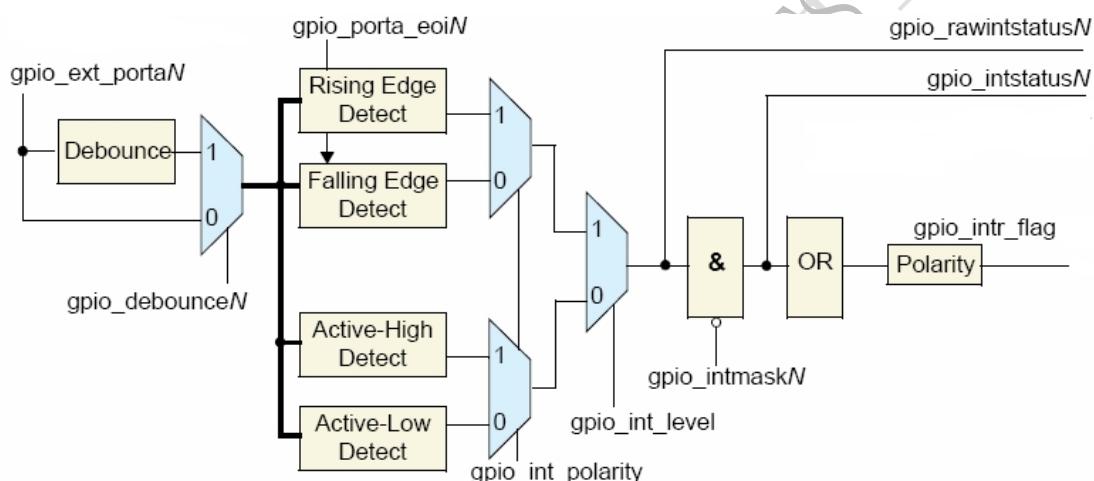


Fig. 37-2 Interrupt RTL Block Diagram

Debounce operation

Port A has been configured to include the debounce capability interrupt feature. The external signal can be debounced to remove any spurious glitches that are less than one period of the external debouncing clock.

When input interrupt signals are debounced using a debounce clock(`pclk`), the signals must be active for a minimum of two cycles of the debounce clock to guarantee that they are registered. Any input pulse widths less than a debounce clock period are bounced. A pulse width between one and two debounce clock widths may or may not propagate, depending on its phase relationship to the debounce clock. If the input pulse spans two rising edges of the debounce clock, it is registered. If it spans only one risingedge, it is not registered.

Synchronization of Interrupt Signals to the System Clock

Interrupt signals are internally synchronized to `pclk`. Synchronization topclk must occur for edge-detect signals. With level-sensitive interrupts, synchronization is optional and under software control(`GPIO_LS_SYNC`).

37.3.2 Programming

Programming Considerations

- Reading from an unused location or unused bits in a particular register always returns zeros. There is no error mechanism in the APB.
- Programming the GPIO registers for interrupt capability, edge-sensitive or level-sensitive interrupts, and interrupt polarity should be completed prior to enabling the interrupts on Port A in order to prevent spurious glitches on the interrupt lines to the interrupt controller.
- Writing to the interrupt clear register clears an edge-detected interrupt and has no effect on a level-sensitive interrupt.

6 GPIOs' hierarchy in the chip

GPIO0, GPIO1, GPIO2 are in CPU subsystem, GPIO3, GPIO4 are in peripheral subsystem, and GPIO6 is in alive subsystem.

37.4 Register description

This chapter describes the control/status registers of the design. Software should read and write these registers using 32-bits accesses. There are 6 GPIOs (GPIO0 ~ GPIO4, GPIO6), and each of them has same register group. Therefore, 6 GPIOs' register groups have 6 different base-address.

37.4.1 Registers Summary

Name	Offset	Size	Reset Value	Description
GPIO_SWPORTA_DR	0x0000	W	0x00000000	Port A data register
GPIO_SWPORTA_DD R	0x0004	W	0x00000000	Port A data direction register
GPIO_INTEN	0x0030	W	0x00000000	Interrupt enable register
GPIO_INTMASK	0x0034	W	0x00000000	Interrupt mask register
GPIO_INTPTYPE LEVE L	0x0038	W	0x00000000	Interrupt level register
GPIO_INT_POLARITY	0x003C	W	0x00000000	Interrupt polarity register
GPIO_INT_STATUS	0x0040	W	0x00000000	Interrupt status of port A
GPIO_INT_RAWSTAT US	0x0044	W	0x00000000	Raw Interrupt status of port A
GPIO_DEBOUNCE	0x0048	W	0x00000000	Debounce enable register
GPIO_PORTA_EOI	0x004C	W	0x00000000	Port A clear interrupt register
GPIO_EXT_PORTA	0x0050	W	0x00000000	Port A external port register
GPIO_LS_SYNC	0x0060	W	0x00000000	Level_sensitive synchronization enable register

Notes: **Size:** **B** – Byte (8 bits) access, **HW** – Half WORD (16 bits) access, **W** – WORD (32 bits) access

37.4.2 Detail Register Description

GPIO_SWPORTA_DR

Address: Operational Base + offset(0x00)

Port A data register

Bit	Attr	Reset Value	Description
31:0	RW	0x00	Values written to this register are output on the I/O signals for Port A if the corresponding data direction bits for Port A are set to Output mode. The value read back is equal to the last value written to this register.

GPIO_SWPORTA_DDR

Address: Operational Base + offset(0x04)

Port A data register

Bit	Attr	Reset Value	Description
31:0	RW	0x00	Values written to this register independently control the direction of the corresponding data bit in Port A. 0: Input (default) 1: Output

GPIO_INTEN

Address: Operational Base + offset(0x30)

Interrupt enable register

Bit	Attr	Reset Value	Description
31:0	RW	0x00	Allows each bit of Port A to be configured for interrupts. Whenever a 1 is written to a bit of this register, it configures the corresponding bit on Port A to become an interrupt; otherwise, Port A operates as a normal GPIO signal. Interrupts are disabled on the corresponding bits of Port A if the corresponding data direction register is set to Output. 0: Configure Port A bit as normal GPIO signal (default) 1: Configure Port A bit as interrupt

GPIO_INTMASK

Address: Operational Base + offset(0x34)

Interrupt mask register

Bit	Attr	Reset Value	Description
31:0	RW	0x00	Controls whether an interrupt on Port A can create an interrupt for the interrupt controller by not masking it. Whenever a 1 is written to a bit in this register, it masks the interrupt generation capability for this signal; otherwise interrupts are allowed through. 0: Interrupt bits are unmasked (default) 1: Mask interrupt

GPIO_INTPTYPE_LEVEL

Address: Operational Base + offset(0x38)

Interrupt level register

Bit	Attr	Reset Value	Description
31:0	RW	0x00	Controls the type of interrupt that can occur on Port A. 0: Level-sensitive (default) 1: Edge-sensitive

GPIO_INT_POLARITY

Address: Operational Base + offset(0x3C)

Interrupt polarity register

Bit	Attr	Reset Value	Description
31:0	RW	0x00	Controls the polarity of edge or level sensitivity that can occur on input of Port A. 0: Active-low (default) 1: Active-high

GPIO_INT_STATUS

Address: Operational Base + offset(0x40)

Interrupt status register

Bit	Attr	Reset Value	Description
31:0	R	0x00	Interrupt status of Port A

GPIO_INT_RAWSTATUS

Address: Operational Base + offset(0x44)

Raw Interrupt status register

Bit	Attr	Reset Value	Description
31:0	R	0x00	Raw interrupt of status of Port A (premasking bits)

GPIO_DEBOUNCE

Address: Operational Base + offset(0x48)

Debounce enable register

Bit	Attr	Reset Value	Description
31:0	RW	0x00	Controls whether an external signal that is the source of an interrupt needs to be debounced to remove any spurious glitches. Writing a 1 to a bit in this register enables the debouncing circuitry. A signal must be valid for two periods of an external clock before it is internally processed. 0: No debounce (default) 1: Enable debounce

GPIO_PORTA_EOI

Address: Operational Base + offset(0x4C)

Port A clear interrupt register

Bit	Attr	Reset Value	Description
31:0	W	0x00	Controls the clearing of edge type interrupts from Port A. When a 1 is written into a corresponding bit of this

			register, the interrupt is cleared. All interrupts are cleared when Port A is not configured for interrupts. 0: No interrupt clear (default) 1: Clear interrupt
--	--	--	---

GPIO_EXT_PORTA

Address: Operational Base + offset(0x50)

Port A external port register

Bit	Attr	Reset Value	Description
31:0	R	0x00	When Port A is configured as Input, then reading this location reads the values on the signal. When the data direction of Port A is set as Output, reading this location reads the data register for Port A.

GPIO_LS_SYNC

Address: Operational Base + offset(0x60)

Level_sensitive synchronization enable register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	RW	0x00	Writing a 1 to this register results in all level-sensitive interrupts being synchronized to pclk_intr. 0: No synchronization to pclk_intr (default) 1: Synchronize to pclk_intr

Chapter 38 Timer

38.1 Overview

Timer is a programmable timer peripheral. This component is an APB slave device. Timers count down from a programmed value and generate an interrupt when the count reaches zero.

The features of timer are as follow:

- Three programmable 32 bits timers
- Two operation modes: free-running and user-defined count
- Maskable for each individual interrupt

38.2 Block Diagram

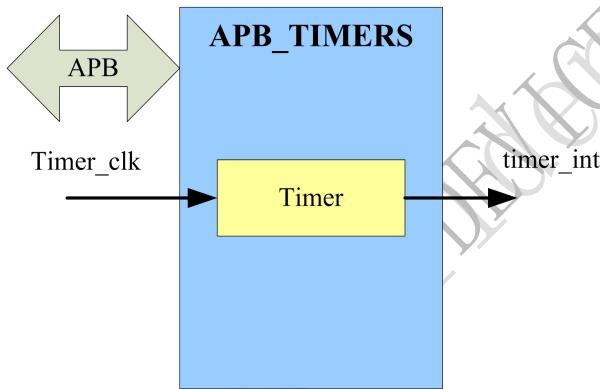


Fig. 38-1 Timer Block Diagram

38.3 Function description

38.3.1 Timer clk selection

Timer0 and timer1 are in the CPU subsystem, and timer clock is 24MHz OSC; Timer2 is in the ALIVE subsystem, and timer clock is 24MHz OSC.

38.3.2 Programming sequence

1. Initialize the timer through the TIMER1_CONTROLREG register:
 - a. Disable the timer by writing a "0" to the timer enable bit (bit 0); accordingly, the timer_enoutput signal is de-asserted.
 - b. Program the timer mode—user-defined or free-running—by writing a "0" or "1," respectively, to the timer mode bit (bit 1).
 - c. Set the interrupt mask as either masked or not masked by writing a "0" or "1," respectively, to the timer interrupt mask bit (bit 2).
2. Load the timer counter value into the TIMER1_LOAD_COUNT register.
3. Enable the timer by writing a "1" to bit 0 of TIMER1_CONTROLREG.

Timers Usage flow

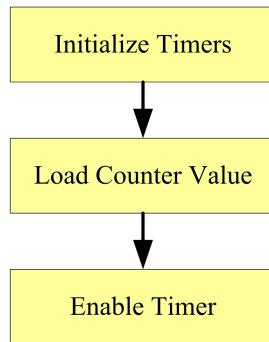


Fig. 38-2 Timer Usage Flow

38.3.3 Enabling and Disabling a Timer

You use bit 0 of the TIMER1_CONTROLREG, to either enable or disable a timer.

Enabling a Timer

If you want to enable a timer, you write a “1” to bit 0 of its TIMER1_CONTROLREG register.

Disabling a Timer

To disable a timer, write a “0” to bit 0 of its TIMER1_CONTROLREG register. When a timer is enabled and running, its counter decrements on each rising edge of its clock signal, timer_N_clk. When a timer transitions from disabled to enabled, the current value of its TIMER1_LOAD_COUNT register is loaded into the timer counter on the next rising edge of timer_N_clk.

When the timer enable bit is de-asserted and the timer stops running, the timer counter and any associated registers in the timer clock domain, such as the toggle register, are asynchronously reset.

When the timer enable bit is asserted, then a rising edge on the timer_en signal is used to load the initial value into the timer counter. A “0” is always read back when the timer is not enabled.

38.3.4 Loading a Timer Countdown Value

The initial value for each timer—that is, the value from which it counts down—is loaded into the timer using the appropriate load count register (TIMER1_LOAD_COUNT). Two events can cause a timer to load the initial count from its TIMER1_LOAD_COUNT register:

- Timer is enabled after being reset or disabled
- Timer counts down to 0

When a timer counts down to 0, it loads one of two values, depending on the timer operating mode:

- User-defined count mode – Timer loads the current value of the TIMER1_LOAD_COUNT register. Use this mode if you want a fixed, timed interrupt. Designate this mode by writing a “1” to bit 1 of TIMER1_CONTROLREG.
- Free-running mode – Timer loads the maximum value, which is dependent on the timer width; that is, the TIMER1_LOAD_COUNT register is comprised of $2^{\text{TIMER_WIDTH_N}} - 1$ bits, all of which are loaded with 1s. The timer counter wrapping to its maximum value allows time to reprogram or disable the timer before another interrupt occurs. Use this mode if you want a single timed interrupt. Designate this mode by writing a “0” to bit 1 of TIMER1_CONTROLREG.

38.4 Register description

This chapter describes the control/status registers of the design. Software should read and write these registers using 32-bits accesses.

There are 3 individual timers. (Timer0 ~ Timer2)

38.4.1 Registers Summary

Name	Offset	Size	Reset Value	Description
TIMER1_LOAD_COUNT	0x0000	W	0x00000000	Timer1 Load Count Register
TIMER1_CURRENT_VALUE	0x0004	W	0x00000000	Timer1 Current Value Register
TIMER1_CONTROLREG	0x0008	W	0x00000000	Timer1 Control Register
TIMER1_EOI	0x000C	W	0x00000000	Timer1 End-of-Interrupt Register
TIMER1_INTSTATUS	0x0010	W	0x00000000	Timer1 Interrupt Status Register
TIMERS_INTSTATUS	0x00a0	W	0x00000000	Timers Interrupt Status Register
TIMERS_EOI	0x00a4	W	0x00000000	Timers End-of-Interrupt Register
TIMERS_RAWSTATUS	0x00a8	W	0x00000000	Timers Raw Interrupt Status Register

Notes: Size: **B** – Byte (8 bits) access, **HW** – Half WORD (16 bits) access, **W** – WORD (32 bits) access

38.4.2 Detail Register Description

TIMER1_LOAD_COUNT

Address: Operational Base + offset(0x00)

Timer1 Load Count Register

Bit	Attr	Reset Value	Description
31:0	RW	0x1f	Value to be loaded into Timer1. This is the value from which counting commences.

TIMER1_CURRENT_VALUE

Address: Operational Base + offset(0x04)

Timer1 Current Value Register

Bit	Attr	Reset Value	Description
31:0	R	0x1f	Current Value of Timer1.

TIMER1_CONTROLREG

Address: Operational Base + offset(0x08)

Timer1 Control Register

Bit	Attr	Reset Value	Description
31:3	-	-	Reserved
2	RW	0x0	Timer interrupt mask. 0: not mask 1: mask

1	RW	0x0	Timer mode. 0: free-running mode 1: user-defined count mode
0	RW	0x0	Timer enable. 0: disable 1: enable

TIMER1_EOI

Address: Operational Base + offset(0x0C)

Timer1 End-of-Interrupt Register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	R	0x0	Reading from this register returns all zeros(0) and clear interrupt from timer1

TIMER1_INTSTATUS

Address: Operational Base + offset(0x10)

Timer1 Interrupt Status Register

Bit	Attr	Reset Value	Description
31:1	-	-	Reserved
0	R	0x0	This register contains the interrupt status for timer1

TIMERS_INTSTATUS

Address: Operational Base + offset(0xa0)

Timers Interrupt Status Register

Bit	Attr	Reset Value	Description
31:3	-	-	Reserved
2	R	0x0	This register contains the interrupt status for timer3
1	R	0x0	This register contains the interrupt status for timer2
0	R	0x0	This register contains the interrupt status for timer1

TIMERS_EOI

Address: Operational Base + offset(0xa4)

Timers End-of-Interrupt Register

Bit	Attr	Reset Value	Description
31:3	-	-	Reserved
2:0	R	0x0	Reading from this register returns all zeros(0) and clear interrupt from all timers

TIMERS_RAWSTATUS

Address: Operational Base + offset(0xa8)

Timers Raw Interrupt Status Register

Bit	Attr	Reset Value	Description
31:3	-	-	Reserved
2	R	0x0	This register contains the interrupt status for timer3 prior to masking
1	R	0x0	This register contains the interrupt status for timer2 prior to masking
0	R	0x0	This register contains the interrupt status for timer1 prior to masking

Notes: Attr: **RW** – Read/writable, **R** – read only, **W** – write only

38.5 Application Notes

timer0 ~ timer2 usage flow

Timer0 and timer1 are in the CPU subsystem, timer2 is in the ALIVE subsystem, and the timer clock of timer0 ~ timer2 is 24MHz OSC. In this case, the timer_clk signal is asynchronous to pclk;

In the condition of the timer_clk signal is asynchronous to pclk. When you disable the timer enable bit (bit 0 of TIMER1_CONTROLREG), the timer_en output signal is de-asserted and, accordingly, timer_clk should stop. Then when you enable the timer, the timer_en signal is asserted and timer_clk should start running.

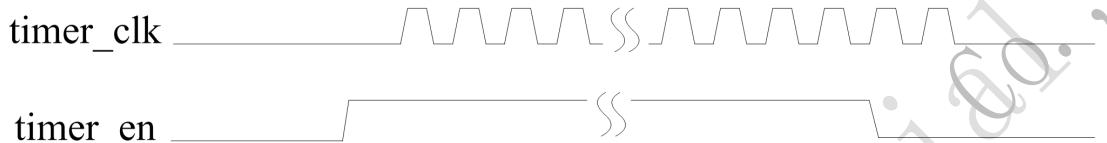


Fig. 38-3 Timing of Timer_en and Timer_clk (timer_clk is async to pclk)

When the timer_clk signal is asynchronous to pclk, the timer usage flow is as follow:

1. Before using the timer, make sure that the timer_clk and timer_en are disabled. (Disable timer0 ~ timer2 clock by writing "1" into CRU_CLKGATE1_CON bit0~bit2 respectively, and disable timer_en by writing a "0" to the timer enable bit (TIMER1_CONTROLREGbit0))
2. Initialize the timer through the TIMER1_CONTROLREG register:
 - a. Program the timer mode—user-defined or free-running—by writing a "0" or "1," respectively, to the timer mode bit (bit 1).
 - b. Set the interrupt mask as either masked or not masked by writing a "0" or "1," respectively, to the timer interrupt mask bit (bit 2).
3. After timer initialization, enable timer_en firstly. (enable the timer by writing a "1" to bit 0 of TIMER1_CONTROLREG)
4. After timer_en enabled, enable timer_clk. (enable timer0 ~ timer2 clock by writing "0" into CRU_CLKGATE1_CON bit0~bit2 respectively.)
5. When you want to disable the timer, firstly, disable the timer_en.
6. After timer_en disabled, disable the timer_clk.

Timers Usage flow(timer_clk signal is asynchronous to pclk)

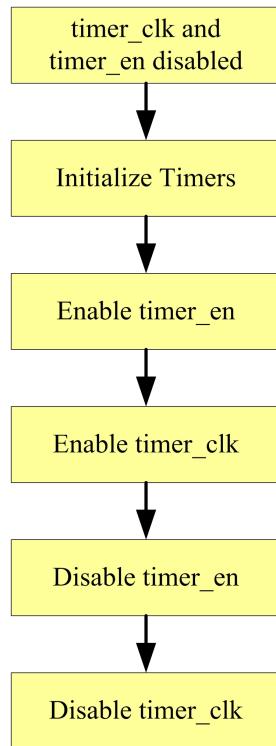


Fig. 38-4 Timer0 and Timer1 Usage Flow

Chapter 39 PWM

39.1 Overview

There are four PWM blocks in PWM Timer (PWM0, PWM1, PWM2 and PWM3). Each PWM block built-in 4-bit pre-scalar from PCLK. The PWM Timer supports both reference mode, which can output various duty-cycle waveforms, and capture, which can measure the duty-cycle of input waveform.

39.1.1 Features

- Built-in three 32 bit timer modulers
- Programmable counter
- Chained timer for long period purpose
- 4-channel 32-bit timer with Pulse Width Modulation(PWM)
- Support maskable interrupt

39.2 Block Diagram

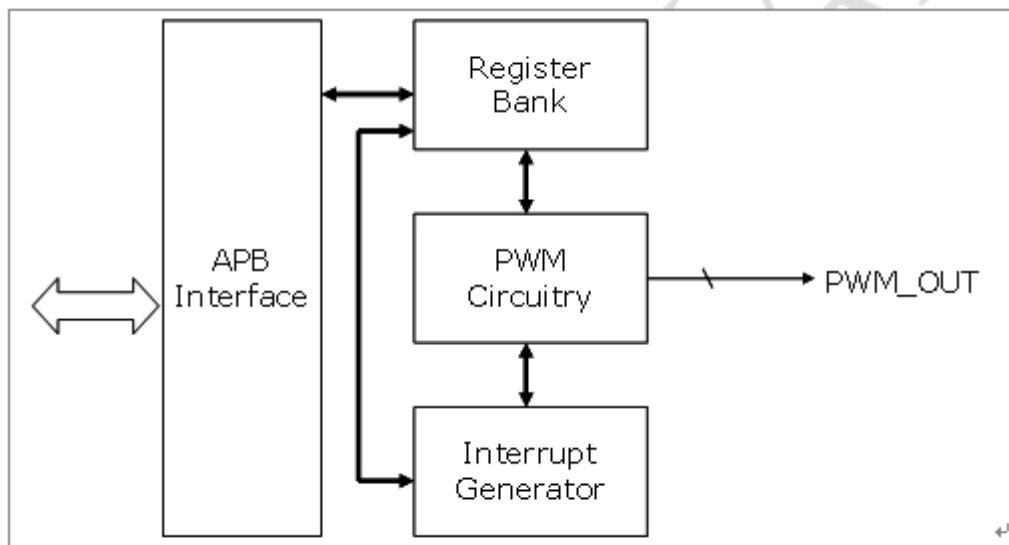


Fig. 39- 1 PWM architecture

PWM Register Block

This block controls the setting of PWM mode.

PWM Circuitry

This block includes clock pre-scalar and reference comparator for PWM timer.

Interrupt Generator

This block handles the interrupt generation, masking, and clearing.

39.3 Register description

39.3.1 Register Summary

Name	Offset	Size	Reset Value	Description
------	--------	------	-------------	-------------

Name	Offset	Size	Reset Value	Description
PWM0_CNTR	0x0000	W	0x00000000	Main counter register
PWM0_HRC	0x0004	W	0x00000000	PWM HIGH Reference/Capture register
PWM0_LRC	0x0008	W	0x00000000	PWM LOW Reference/Capture register
PWM0_CTRL	0x000c	W	0x00000000	Current value register
PWM1_CNTR	0x0010	W	0x00000000	Main counter register
PWM1_HRC	0x0014	W	0x00000000	PWM HIGH Reference/Capture register
PWM1_LRC	0x0018	W	0x00000000	PWM LOW Reference/Capture register
PWM1_CTRL	0x001c	W	0x00000000	Current value register
PWM2_CNTR	0x0020	W	0x00000000	Main counter register
PWM2_HRC	0x0024	W	0x00000000	PWM HIGH Reference/Capture register
PWM2_LRC	0x0028	W	0x00000000	PWM LOW Reference/Capture register
PWM2_CTRL	0x002c	W	0x00000000	Current value register
PWM3_CNTR	0x0030	W	0x00000000	Main counter register
PWM3_HRC	0x0034	W	0x00000000	PWM HIGH Reference/Capture register
PWM3_LRC	0x0038	W	0x00000000	PWM LOW Reference/Capture register
PWM3_CTRL	0x003c	W	0x00000000	Current value register

Notes: **Size:** **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

39.3.2 Detail Register Description

PWMn_CNTR (n=0~3)

Address: Operational Base + offset (0x00, 0x10, 0x20, 0x30)
Main counter register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	main_pwm_timer_cnt Main PWM timer counter. Counting value ranges from 0 ~ (2^32 -1).

PWMn_HRC (n=0~3)

Address: Operational Base + offset (0x04, 0x14, 0x24, 0x34)
PWM HIGH Reference/Capture register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	high_reference_cap PWM HIGH reference/capture registers

PWMn_LRC (n=0~3)

Address: Operational Base + offset (0x08, 0x18, 0x28, 0x38)
PWM LOW Reference/Capture register

Bit	Attr	Reset Value	Description
31:0	RW	0x00000000	loe_reference_cap PWM LOW reference/capture registers

PWMn_CTRL (n=0~3)

Address: Operational Base + offset (0x0C, 0x1C, 0x2C, 0x3C)

Current value register

Bit	Attr	Reset Value	Description																
31:13	RO	0x0	reserved																
12:9	RW	0x0	<p>prescale_factor Prescale factor.</p> <table> <tr><td>0000: 1/2</td><td>0001: 1/4</td></tr> <tr><td>0010: 1/8</td><td>0011: 1/16</td></tr> <tr><td>0100: 1/32</td><td>0101: 1/64</td></tr> <tr><td>0110: 1/128</td><td>0111: 1/256</td></tr> <tr><td>1000: 1/512</td><td>1001: 1/1024</td></tr> <tr><td>1010: 1/2048</td><td>1011: 1/4096</td></tr> <tr><td>1100: 1/8192</td><td>1101: 1/16384</td></tr> <tr><td>1110: 1/32768</td><td>1111: 1/65536</td></tr> </table>	0000: 1/2	0001: 1/4	0010: 1/8	0011: 1/16	0100: 1/32	0101: 1/64	0110: 1/128	0111: 1/256	1000: 1/512	1001: 1/1024	1010: 1/2048	1011: 1/4096	1100: 1/8192	1101: 1/16384	1110: 1/32768	1111: 1/65536
0000: 1/2	0001: 1/4																		
0010: 1/8	0011: 1/16																		
0100: 1/32	0101: 1/64																		
0110: 1/128	0111: 1/256																		
1000: 1/512	1001: 1/1024																		
1010: 1/2048	1011: 1/4096																		
1100: 1/8192	1101: 1/16384																		
1110: 1/32768	1111: 1/65536																		
8	RW	0x0	<p>cap_mode_en Capture mode enable/disable 0: Disable 1: Enable</p>																
7	W1C	0x0	<p>pwm_reset PWM reset. 0: Normal operation 1: Reset PWM</p>																
6	W1C	0x0	<p>int_status_clr Interrupt status and clear bit. Write "1" to clear interrupt status.</p>																
5	RW	0x0	<p>pwm_timer_int_en PWM timer interrupt enable/disable. PWM timer will assert an interrupt when PWMTx_CNTR value is equal to the value of PWMTx_LRC or PWMTx_HRC. 0: Disable 1: Enable</p>																
4	RW	0x0	<p>single_cnt_mode Single counter mode. 0: PWMTx_CNTR is restarted after it reaches value equal to the PWMTx_LRC value. 1: PWMTx_CNTR is not increased anymore after it reaches value equal to the PWMTx_LRC value.</p>																
3	RW	0x0	<p>pwm_output_en PWM output enable/disable. 0: Disable 1: Enable</p>																

Bit	Attr	Reset Value	Description
2:1	RO	0x0	reserved
0	RW	0x0	pwm_timer_en PWM timer enable/disable. 0: Disable 1: Enable

39.4 Interface description

Table 39- 1 PWM Interface Description

Module pin	Direction	Pad name	IOMUX
pwm3	O	GPIO3_D[6]	GRF_GPIO0D_IOMUX[13:12]=01
pwm2	O	GPIO3_D[5]	GRF_GPIO0D_IOMUX[11:10]=01
pwm1	O	GPIO3_D[4]	GRF_GPIO0A_IOMUX[9:8]=01
pwm0	O	GPIO3_D[3]	GRF_GPIO0A_IOMUX[6]=1

Chapter 40 WatchDog

40.1 Overview

Watchdog Timer (WDT) is an APB slave peripheral that can be used to prevent system lockup that may be caused by conflicting parts or programs in a SoC. The WDT would generate interrupt or reset signal when its counter reaches zero, then a reset controller would reset the system.

The features of WDT are as follows:

- 32 bits APB bus width
- WDT counter's clock is pclk
- 32 bits WDT counter width
- Counter counts down from a preset value to 0 to indicate the occurrence of a timeout
- WDT can perform two types of operations when timeout occurs:
 - (1) Generate a system reset;
 - (2) First generate an interrupt and if this is not cleared by the service routine by the time a second timeout occurs then generate a system reset
- Programmable reset pulse length
- Total 16 defined ranges of main timeout period

40.2 Block Diagram

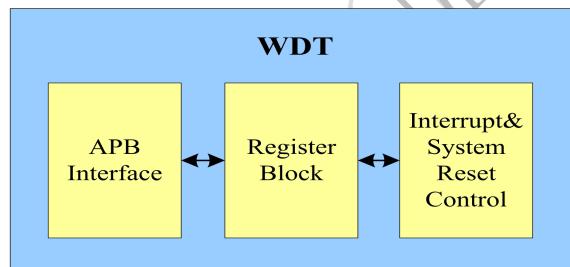


Fig. 40-1 WDT block diagram

Block Descriptions:

APB Interface

The APB Interface implements the APB slave operation. Its bus width is 32 bits.

Register Block

A register block with read coherency for the current count register.

Interrupt & system reset control

An interrupt/system reset generation block comprising of a decrementing counter and control logic.

40.3 Function Description

40.3.1 Operation

Counter

The WDT counts from a preset (timeout) value in descending order to zero.

When the counter reaches zero, depending on the output response mode selected, either a system reset or an interrupt occurs. When the counter reaches zero, it wraps to the selected timeout value and continues decrementing. The user can restart the counter to its initial value. This is programmed by writing to the restart register at any time. The process of restarting the watchdog counter is sometimes referred to as kicking the dog. As a safety feature to prevent accidental restarts, the value 0x76 must be written to the Current Counter Value Register (WDT_CRR).

Interrupts

The WDT can be programmed to generate an interrupt (and then a system reset) when a timeout occurs. When a 1 is written to the response mode field (RMOD, bit 1) of the Watchdog Timer Control Register (WDT_CR), the WDT generates an interrupt. If it is not cleared by the time a second timeout occurs, then it generates a system reset. If a restart occurs at the same time the watchdog counter reaches zero, an interrupt is not generated.

System Resets

When a 0 is written to the output response mode field (RMOD, bit 1) of the Watchdog Timer Control Register (WDT_CR), the WDT generates a system reset when a timeout occurs.

Reset Pulse Length

The reset pulse length is the number of pclk cycles for which a system reset is asserted. When a system reset is generated, it remains asserted for the number of cycles specified by the reset pulse length or until the system is reset. A counter restart has no effect on the system reset once it has been asserted.

40.3.2 Programming sequence

Operation Flow Chart (Response mode=1)

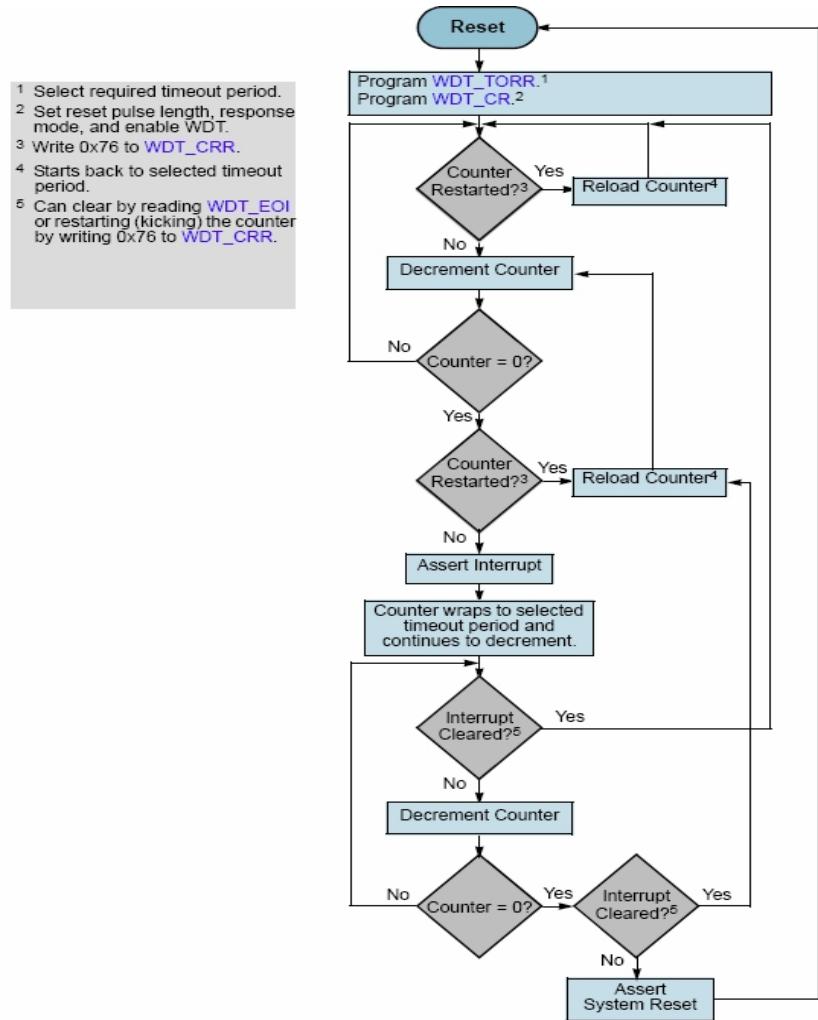


Fig. 40-2 WDT Operation Flow

40.4 Register description

40.4.1 Register Summary

Name	Offset	Size	Reset Value	Description
WDT_CR	0x0000	W	0x0000000a	Control Register
WDT_TORR	0x0004	W	0x00000000	Timeout range Register
WDT_CCVR	0x0008	W	0x00000000	Current counter value Register
WDT_CRR	0x000c	W	0x00000000	Counter restart Register
WDT_STAT	0x0010	W	0x00000000	Interrupt status Register
WDT_EOI	0x0014	W	0x00000000	Interrupt clear Register

Notes: **S**- Byte (8 bits) access, **H**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

40.4.2 Detail Register Description

WDT_CR

Address: Operational Base + offset (0x0000)

Control Register

Bit	Attr	Reset Value	Description
-----	------	-------------	-------------

Bit	Attr	Reset Value	Description
31:5	RO	0x0	reserved
4:2	RW	0x2	<p>rst_pluse_lenth Reset pulse length. This is used to select the number of pclk cycles for which the system reset stays asserted.</p> <p>000: 2 pclk cycles 001: 4 pclk cycles 010: 8 pclk cycles 011: 16 pclk cycles 100: 32 pclk cycles 101: 64 pclk cycles 110: 128 pclk cycles 111: 256 pclk cycles</p>
1	RW	0x1	<p>resp_mode Response mode. Selects the output response generated to a timeout.</p> <p>0: Generate a system reset. 1: First generate an interrupt and if it is not cleared by the time a second timeout occurs then generate a system reset.</p>
0	RW	0x0	<p>wdt_en WDT enable 0: WDT disabled; 1: WDT enabled.</p>

WDT_TORR

Address: Operational Base + offset (0x0004)

Timeout range Register

Bit	Attr	Reset Value	Description
31:4	RO	0x0	reserved

Bit	Attr	Reset Value	Description
3:0	RW	0x0	<p>timeout_period Timeout period. This field is used to select the timeout period from which the watchdog counter restarts. A change of the timeout period takes effect only after the next counter restart (kick). The range of values available for a 32-bit watchdog counter are:</p> <ul style="list-style-type: none"> 0000: 0x0000ffff 0001: 0x0001ffff 0010: 0x0003ffff 0011: 0x0007ffff 0100: 0x000fffff 0101: 0x001fffff 0110: 0x003fffff 0111: 0x007fffff 1000: 0x00ffffff 1001: 0x01ffffff 1010: 0x03ffffff 1011: 0x07ffffff 1100: 0x0fffffff 1101: 0x1fffffff 1110: 0x3fffffff 1111: 0x7fffffff

WDT_CCVR

Address: Operational Base + offset (0x0008)

Current counter value Register

Bit	Attr	Reset Value	Description
31:0	RO	0x00000000	<p>cur_cnt Current counter value This register, when read, is the current value of the internal counter. This value is read coherently when ever it is read</p>

WDT_CRR

Address: Operational Base + offset (0x000c)

Counter restart Register

Bit	Attr	Reset Value	Description
31:8	RO	0x0	reserved

Bit	Attr	Reset Value	Description
7:0	W1C	0x00	<p>cnt_restart Counter restart</p> <p>This register is used to restart the WDT counter. As a safety feature to prevent accidental restarts, the value 0x76 must be written. A restart also clears the WDT interrupt. Reading this register returns zero.</p>

WDT_STAT

Address: Operational Base + offset (0x0010)

Interrupt status Register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RO	0x0	<p>wdt_status</p> <p>This register shows the interrupt status of the WDT.</p> <p>1: Interrupt is active regardless of polarity; 0: Interrupt is inactive.</p>

WDT_EOI

Address: Operational Base + offset (0x0014)

Interrupt clear Register

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RO	0x0	<p>wdt_int_clr</p> <p>Clears the watchdog interrupt. This can be used to clear the inter</p> <p>Clears the watchdog interrupt. This can be used to clear the interrupt without restarting the watchdog counter.</p>

Chapter 41 SAR-ADC

41.1 Overview

The ADC is an 4-channel signal-ended 10-bit Successive Approximation Register (SAR) A/D Converter. It uses the supply and ground as its reference which avoid use of any external reference. It converts the analog input signal into 10-bit binary digital codes at maximum conversion rate of 100KSPS with 1MHz A/D converter clock.

41.2 Block Diagram

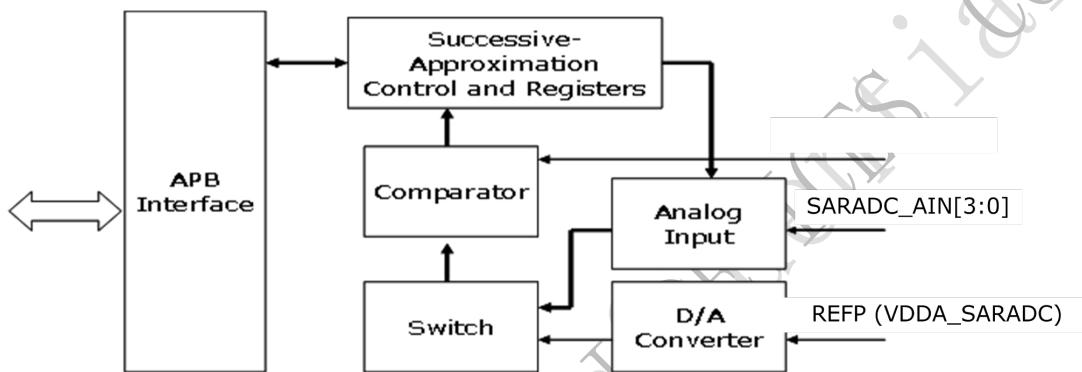


Fig. 41- 1 RK3168 SAR-ADC block diagram

Successive-Approximate Register and Control Logic Block

This block is exploited to realize binary search algorithm, storing the intermediate result and generate control signal for analog block.

Comparator Block

This block compares the analog input SARADC_AIN[3:0] with the voltage generated from D/A Converter, and output the comparison result to SAR and Control Logic Block for binary search. Three level amplifiers are employed in this comparator to provide enough gain.

41.3 Function Description

In RK3168, SAR-ADC work at single-sample operation mode.

- Single-sample conversion

This mode is useful to sample an analog input when there is a gap between two samples to be converted. In this mode START is asserted only on the rising edge of CLKIN where conversion is needed. At the end of every conversion EOC signal is made high and valid output data is available at the rising edge of EOC. The detailed timing diagram will be shown in the following.

41.4 Register description

41.4.1 Register Summary

Name	Offset	Size	Reset Value	Description
SARADC_DATA	0x0000	W	0x00000000	This register contains the data after A/D Conversion.
SARADC_STAS	0x0004	W	0x00000000	The status register of A/D Converter.
SARADC_CTRL	0x0008	W	0x00000000	The control register of A/D Converter.
SARADC_DLY_PU_SOC	0x000c	W	0x00000000	delay between power up and start command

Notes: **Size:** **B**- Byte (8 bits) access, **HW**- Half WORD (16 bits) access, **W**-WORD (32 bits) access

41.4.2 Detail Register Description

SARADC_DATA

Address: Operational Base + offset (0x0000)

This register contains the data after A/D Conversion.

Bit	Attr	Reset Value	Description
31:10	RO	0x0	reserved
9:0	RO	0x000	adc_data A/D value of the last conversion (DOUT[9:0]).

SARADC_STAS

Address: Operational Base + offset (0x0004)

The status register of A/D Converter.

Bit	Attr	Reset Value	Description
31:1	RO	0x0	reserved
0	RO	0x0	adc_status ADC status (EOC) 0: ADC stop; 1: Conversion in progress.

SARADC_CTRL

Address: Operational Base + offset (0x0008)

The control register of A/D Converter.

Bit	Attr	Reset Value	Description
31:7	RO	0x0	reserved

Bit	Attr	Reset Value	Description
6	RW	0x0	int_status Interrupt status. This bit will be set to 1 when end-of-conversion. Set 0 to clear the interrupt.
5	RW	0x0	int_en Interrupt enable. 0: Disable; 1: Enable
4	RO	0x0	reserved
3	RW	0x0	adc_power_ctrl ADC power down control bit 0: ADC power down; 1: ADC power up and reset. start signal will be asserted (DLY_PU_SOC+2) sclk clock period later after power up
2:0	RW	0x0	adc_input_src_sel ADC input source selection(CH_SEL[2:0]). 111 : Input source 0 (SARADC_AIN[0]) 110 : Input source 1 (SARADC_AIN[1]) 101 : Input source 2 (SARADC_AIN[2]) 100 : Input source 3 (SARADC_AIN[3]) Others : Reserved

SARADC_DLY_PU_SOC

Address: Operational Base + offset (0x000c)
delay between power up and start command

Bit	Attr	Reset Value	Description
31:6	RO	0x0	reserved
5:0	RW	0x08	DLY_PU_SOC delay between power up and start command The start signal will be asserted (DLY_PU_SOC + 2) sclk clock period later after power up

41.5 Timing Diagram

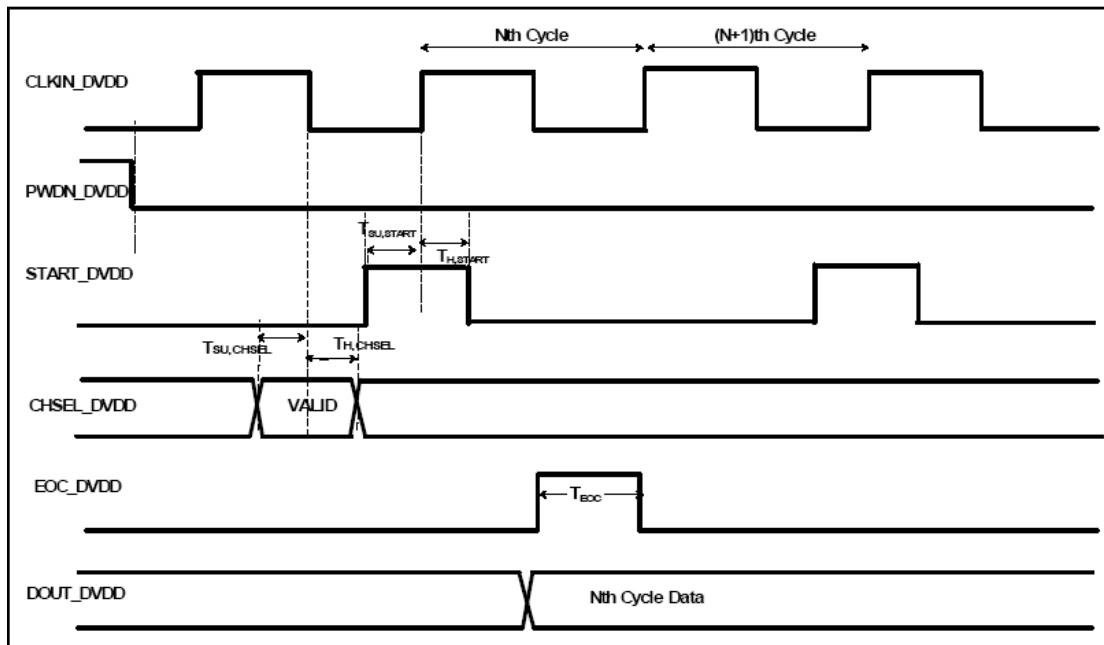


Fig. 41- 2SAR-ADC timing diagram in single-sample conversion mode

The following table has shows the detailed value for timing parameters in the above diagram.

Table 41- 1 RK3168 eFuse timing parameters list

Timing	Symbol	Value			Unit	Description
		Min	Typ	Max		
START_OF_CONV Setup time	TSU,START	5			ns	Set Up time for START_OF_CONV w.r.t CLKIN rising edge
START_OF_CONV Hold time	TH,START	5			ns	Hold time for START_OF_CONV w.r.t CLKIN rising edge
CHSEL setup time	TSU,CHSEL	5			ns	Set Up time for CHSEL w.r.t CLKIN falling edge
CHSEL Hold time	TH,CHSEL	5			ns	Hold time for CHSEL w.r.t CLKIN falling edge
Data Setup	TSU,DATA	400		900	ns	Set Up time for output data w.r.t either CLKIN rising edge or END_OF_CONV falling edge
Data Hold	TH,DATA	100		600	ns	Hold time for output data w.r.t either CLKIN rising edge or END_OF_CONV falling edge
Data access time	TDAC	100		600	ns	Valid data w.r.t CLKIN rising edge
Delay time	TDelay			5	ns	Delay between Valid data and EOC_DVDD rising edge
EOC Pulse Width (max frequency)	TEOC	400		900	ns	Pulse width of EOC
CLKIN Rise Time	TCR			2	ns	CLKIN Rise Time
CLKIN Fall Time	TCF			2	ns	CLKIN Fall Time
CLK Pulse Width(Duty Cycle)	TCPW	45		55	%	CLKIN High/Low Time Period
CLK Period	TCP	1			us	CLKIN Time Period

41.6 Application Notes

The following is an example sequence of setting up A/D Converter, starting of conversion, and acquiring the result value.

- Power-down A/D Converter in SARADC_CTRL[3]

- Power-up A/D Converter in SARADC_CTRL[3] and select input channel of A/D Converter in SARADC_CTRL[2:0] bit
- Wait an A/D interrupt or poll the SARADC_STAS register to determine when the conversion is completed
- Read the conversion result in the SARADC_DATA register

Another, as for input clock period of SAR-ADC , it must be minimum 1000ns .

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Chapter 42 eFuse

42.1 Overview

In RK3168, eFuse is organized as 32bits by 8 one-time programmable electrical fuses with random access interface. It is a type of non-volatile memory fabricated in standard CMOS logic process. The main features are as follows :

- Programming condition : $V_{QPS_EFUSE} = 1.5V \pm 10\%$, Program time : $10\mu s \pm 0.2\mu s$.
- Read condition : $V_{QPS_EFUSE} = 0V$
- Provide standby mode

For detailed information about **eFuse**, please refer to **RK3168 eFuse.pdf**.

Chapter 43 Chip Test Solution

43.1 Overview

In RK3168, there are lots of test modes for different intention as the following table, which will be decided by signals test and $testmode_i$ ($i=0\sim 3$) , which is muxed with function GPIO.

Table 43-1 RK3168 test mode list

TEST	testmode3	testmode2	testmode1	testmode0	mode description
0	X	X	X	X	Normal mode
1	0	0	0	0	SOC general scan test mode
1	0	0	0	1	SOC at-speed scan test mode
1	0	0	1	0	SOC general memory bist mode / SOC general Rom bist mode
1	0	0	1	1	SOC at-speed memory bist mode / SOC at-speed Rom bist mode
1	0	1	0	1	Cortex-A9(L1) at-speed memory bist mode
1	0	1	1	0	Cortex-A9(L2) at-speed memory bist mode
1	0	1	1	1	SOC leakage test mode
1	1	0	0	1	DDR PHY test mode
1	1	0	1	0	Reserved
1	1	0	1	1	PLL test mode
1	1	1	0	0	eFuse test mode
1	1	1	0	1	10bit SAR-ADC test mode
1	1	1	1	0	Reserved

The key application notes are as follows :

- For SOC at-speed scan test mode, RK3168 provides six test solution with different internal test frequency, which is decided by signals test_freq_sel_i (i=0~2), and need four input clocks from XIN24M, CIF_VSYNC,CLK32K and DDRIO_RET_EN input pins.
- For SOC at-speed RAM/ROM bist mode and Cortex-A9(L1/L2) at-speed memory bist mode, RK3168 provides six test solution with different test frequency, which is decided by signals test_freq_sel_i (i=0~1), and only need one input clock from XIN24M input pin.
- For SOC general scan test mode, RK3168 need three input clocks from CIF_VSYNC,CLK32K and DDRIO_RET_EN input pins with 24MHz frequency.
- For SOC general RAM/ROM bist mode , RK3168 only need one input clock from XIN24M input pin with 24MHz frequency.
- For DDR PHY test mode , RK3168 provides six test solution with different test frequency, which is decided by signals test_freq_sel_i (i=0~1), and only need one input clock from XIN24M input pin.
- For all other test modes for internal analog macro inside RK3168 , only need one input clock from XIN24M input pin with 24MHz frequency.
- The reset signal for all of test modes is all from NPOR input pin directly.
- The frequency of input test clock is not fixed 24MHz for the following test mode, which depends on the test clock frequency selection. For the detailed information about the input test clock frequency, please refer to the test

mode description chapter later.

- at-speed scan test mode
- at-speed RAM/ROM memory bist mode
- Cortex-A9(L1) at-speed memory bist mode
- DDR PHY test mode

In the above description, some miscellaneous signals related with test mode are not dedicated pins, always mux with function pin except TEST. The detailed information is as the following list.

Table 43-2 RK3168 iomux for misc signal in test mode

test pins	test IO	function pins	IOMUX setting
testmode0	I	CIF_DATA[2]	TEST = high level
testmode1	I	CIF_DATA[3]	TEST = high level
testmode2	I	CIF_DATA[4]	TEST = high level
testmode3	I	CIF_DATA[5]	TEST = high level
test_freq_sel0	I	CIF_DATA[7]	TEST = high level
test_freq_sel1	I	CIF_DATA[8]	TEST = high level
test_freq_sel2	I	CIF_DATA[9]	TEST = high level

For detailed information about **Chip Test Solution**, please refer to **RK3168 Chip Test Solution.pdf**.

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